Kinetis KE1xZ256 Sub-Family Reference Manual

Supports: MKE15Z256VLL7, MKE15Z256VLH7; MKE15Z128VLL7, MKE15Z128VLH7; MKE14Z256VLL7, MKE14Z256VLH7; MKE14Z128VLH7.

Document Number: KE1xZP100M72SF0RM

Rev. 3, 07/2018



2 NXP Semiconductors

Contents

Sec	ction number Title	Page
	Chapter 1 About This Manual	
1.1	Audience	43
1.2	Organization	43
1.3	Module descriptions.	43
	1.3.1 Example: chip-specific information that supersedes content in the same chapter	44
	1.3.2 Example: chip-specific information that refers to a different chapter	45
1.4	Register descriptions.	46
1.5	Conventions	47
	1.5.1 Numbering systems.	47
	1.5.2 Typographic notation	47
	1.5.3 Special terms	48
	Chapter 2 Introduction	
2.1	Overview	49
2.2	Block Diagram	49
2.3	Module Functional Categories.	50
	Chapter 3 Core Overview	
3.1	ARM Cortex-M0+	53
3.2	Core Buses and Interfaces	54
3.3	Core Component Configuration.	55
3.4	SysTick Clock Configuration	55
	Chapter 4 Interrupts	
4.1	Introduction	57
4.2	NVIC configuration.	57
	4.2.1 Interrupt priority levels	57

Section number		ımber Title	Page	
	4.2.2	Non-maskable interrupt	58	
4.3	Interrup	ot channel assignments	58	
	4.3.1	Determining the bitfield and register location for configuring a particular interrupt	60	
		Chapter 5 System Integration Module (SIM)		
5.1	Introdu	ction	63	
	5.1.1	Features	63	
5.2	Memor	y map and register definition	63	
	5.2.1	Chip Control register (SIM_CHIPCTL)	64	
	5.2.2	FTM Option Register 0 (SIM_FTMOPT0)	66	
	5.2.3	ADC Options Register (SIM_ADCOPT)	67	
	5.2.4	FTM Option Register 1 (SIM_FTMOPT1)	69	
	5.2.5	System Device Identification Register (SIM_SDID)	71	
	5.2.6	Flash Configuration Register 1 (SIM_FCFG1)	72	
	5.2.7	Flash Configuration Register 2 (SIM_FCFG2)	74	
	5.2.8	Unique Identification Register High (SIM_UIDH)	75	
	5.2.9	Unique Identification Register Mid-High (SIM_UIDMH)	75	
	5.2.10	Unique Identification Register Mid Low (SIM_UIDML)	76	
	5.2.11	Unique Identification Register Low (SIM_UIDL)	76	
	5.2.12	Miscellaneous Control register (SIM_MISCTRL)	77	
		Chapter 6 Memory-Mapped Divide and Square Root (MMDVSQ)		
6.1	Chip-sp	pecific Information for this Module	79	
6.2	Introdu	ction	79	
	6.2.1	Features	79	
	6.2.2	Block diagram.	80	
	6.2.3	Modes of operation	82	
6.3	Externa	al signal description	83	
6.4	Memory map and register definition			

Section number Title		Page	
	6.4.1	Dividend Register (MMDVSQ_DEND)	84
	6.4.2	Divisor Register (MMDVSQ_DSOR)	84
	6.4.3	Control/Status Register (MMDVSQ_CSR)	86
	6.4.4	Result Register (MMDVSQ_RES)	89
	6.4.5	Radicand Register (MMDVSQ_RCND)	89
6.5	Function	onal description.	90
	6.5.1	Algorithms	90
	6.5.2	Execution times.	93
	6.5.3	Software interface.	95
		Chapter 7 Miscellaneous Control Module (MCM)	
7.1	Chip-s	pecific Information for this Module	97
7.2	Introduction.		98
	7.2.1	Features	98
7.3	Memo	98	
	7.3.1	Crossbar Switch (AXBS) Slave Configuration (MCM_PLASC)	99
	7.3.2	Crossbar Switch (AXBS) Master Configuration (MCM_PLAMC)	99
	7.3.3	Platform Control Register (MCM_PLACR)	100
	7.3.4	Compute Operation Control Register (MCM_CPO)	103
		Chapter 8 Bit Manipulation Engine (BME)	
8.1	Chip-s	pecific Information for this Module	105
8.2	Introdu	action	105
	8.2.1	Overview	106
	8.2.2	Features	107
	8.2.3	Modes of operation	107
8.3	Memor	ry map and register definition	107
8.4	Function	onal description.	108
	8.4.1	BME decorated stores.	108

Section number		umber Title	Page
	8.4.2	BME decorated loads	115
	8.4.3	Additional details on decorated addresses and GPIO accesses	121
8.5	Applica	ation information	122
		Chapter 9 Crossbar Switch Lite (AXBS-Lite)	
9.1	Chip-s ₁	pecific Information for this Module	125
9.2	Introdu	ction	126
	9.2.1	Features	126
9.3	Memor	y Map / Register Definition	127
9.4	Function	onal Description	127
	9.4.1	General operation.	127
	9.4.2	Arbitration	128
9.5	Initializ	zation/application information	129
		Chapter 10 Peripheral Bridge (AIPS-Lite)	
10.1	Chip-s ₁	pecific information for this module	131
	10.1.1	Instantiation Information	131
10.2	Introdu	ction	132
	10.2.1	Features	132
	10.2.2	General operation	133
10.3	Memor	y map/register definition	133
10.4	Function	onal description	133
	10.4.1	Access support	
		Chapter 11 Trigger MUX Control (TRGMUX)	
11.1	Chip-s ₁	pecific information for this module	135
	11.1.1	Module Interconnectivity	
11.2	Introdu	ction	140
	11.2.1	Features	140
11.3	Function	onal description	140
		Kinetis KE1xZ256 Sub-Family Reference Manual, Rev	v. 3, 07/2018

Sec	ection number Title		Page	
11.4	Memor	y map and register definition	140	
	11.4.1	TRGMUX1 Register Descriptions.	140	
	11.4.2	TRGMUX0 Register Descriptions.	145	
11.5	Usage (Guide	176	
	11.5.1	ADC Trigger Source	176	
	11.5.2	CMP Window/Sample Input	177	
	11.5.3	FTM Fault Detection Input / Hardware Triggers and Synchronization	177	
		Chapter 12 Direct Memory Access Multiplexer (DMAMUX)		
12.1	Chip-sp	pecific information for this module	179	
	12.1.1	DMAMUX request sources	179	
	12.1.2	DMA trigger sources	181	
12.2	Introduction			
	12.2.1	Overview	181	
	12.2.2	Features	182	
	12.2.3	Modes of operation	182	
12.3	Externa	al signal description	183	
12.4	Memor	y map/register definition	183	
	12.4.1	Channel Configuration register (DMAMUX_CHCFGn)	184	
12.5	Function	onal description	185	
	12.5.1	DMA channels with periodic triggering capability	185	
	12.5.2	DMA channels with no triggering capability	187	
	12.5.3	Always-enabled DMA sources	187	
12.6	Initializ	zation/application information	189	
	12.6.1	Reset	189	
	12.6.2	Enabling and configuring sources	189	
		Chapter 13 Enhanced Direct Memory Access (eDMA)		
13.1	Introdu	ction	193	

Sec	tion nu	mber Title	Page
	13.1.1	eDMA system block diagram	
	13.1.2	Block parts	
	13.1.3	Features.	195
13.2	Modes	of operation	196
13.3	Memory	map/register definition	197
	13.3.1	TCD memory	197
	13.3.2	TCD initialization.	197
	13.3.3	TCD structure	197
	13.3.4	Reserved memory and bit fields	198
	13.3.5	Control Register (DMA_CR)	204
	13.3.6	Error Status Register (DMA_ES)	
	13.3.7	Enable Request Register (DMA_ERQ)	209
	13.3.8	Enable Error Interrupt Register (DMA_EEI)	211
	13.3.9	Clear Enable Error Interrupt Register (DMA_CEEI)	212
	13.3.10	Set Enable Error Interrupt Register (DMA_SEEI)	213
	13.3.11	Clear Enable Request Register (DMA_CERQ)	214
	13.3.12	Set Enable Request Register (DMA_SERQ)	215
	13.3.13	Clear DONE Status Bit Register (DMA_CDNE)	216
	13.3.14	Set START Bit Register (DMA_SSRT)	217
	13.3.15	Clear Error Register (DMA_CERR)	218
	13.3.16	Clear Interrupt Request Register (DMA_CINT)	219
	13.3.17	Interrupt Request Register (DMA_INT)	220
	13.3.18	Error Register (DMA_ERR)	221
	13.3.19	Hardware Request Status Register (DMA_HRS)	223
	13.3.20	Enable Asynchronous Request in Stop Register (DMA_EARS)	225
	13.3.21	Channel n Priority Register (DMA_DCHPRIn)	226
	13.3.22	TCD Source Address (DMA_TCDn_SADDR)	227
	13.3.23	TCD Signed Source Address Offset (DMA_TCDn_SOFF)	227
	13.3.24	TCD Transfer Attributes (DMA_TCDn_ATTR)	228

tion nu	mber Title	Page
13.3.25	TCD Minor Byte Count (Minor Loop Mapping Disabled) (DMA_TCDn_NBYTES_MLNO)	229
13.3.26		229
13.3.27		231
13.3.28	TCD Last Source Address Adjustment (DMA_TCDn_SLAST)	232
13.3.29	TCD Destination Address (DMA_TCDn_DADDR)	232
13.3.30	TCD Signed Destination Address Offset (DMA_TCDn_DOFF)	233
13.3.31		233
13.3.32		235
13.3.33	TCD Last Destination Address Adjustment/Scatter Gather Address (DMA_TCDn_DLASTSGA)	236
13.3.34	TCD Control and Status (DMA_TCDn_CSR)	236
13.3.35		239
13.3.36		240
Function	nal description	241
13.4.1	eDMA basic data flow	241
13.4.2	Fault reporting and handling.	244
13.4.3	Channel preemption.	246
13.4.4	Performance	246
Initializa	ation/application information	251
13.5.1	eDMA initialization.	251
13.5.2	Programming errors	253
13.5.3	Arbitration mode considerations.	253
13.5.4	Performing DMA transfers	254
13.5.5	Monitoring transfer descriptor status	258
13.5.6	Channel Linking	260
	13.3.25 13.3.26 13.3.27 13.3.28 13.3.29 13.3.30 13.3.31 13.3.35 13.3.36 Function 13.4.1 13.4.2 13.4.3 13.4.4 Initialization 13.5.1 13.5.2 13.5.3 13.5.5	13.3.25 TCD Minor Byte Count (Minor Loop Mapping Disabled) (DMA_TCDn_NBYTES_MLNO)

NXP Semiconductors 9

Sec	tion nu	umber Title	Page
	13.5.7	Dynamic programming	261
	13.5.8	Suspend/resume a DMA channel with active hardware service requests	264
13.6	Usage (Guide	266
		Chapter 14 Memory and memory map	
14.1	Introdu	ction	267
14.2	Flash m	nemory	
	14.2.1	Flash memory types	
	14.2.2	Flash Memory Sizes	269
14.3	SRAM	memory	270
	14.3.1	SRAM sizes	270
	14.3.2	SRAM retention in low power modes	270
14.4	System	memory map	270
	14.4.1	Aliased bit-band regions	272
	14.4.2	Bit Manipulation Engine	273
14.5	Periphe	eral memory map	273
	14.5.1	Peripheral Bridge (AIPS-Lite) Memory Map	274
14.6	Private	Peripheral Bus (PPB) memory map	277
		Chapter 15 Flash Acceleration Unit (FAU)	
15.1	Flash A	Acceleration Unit (FAU)	279
	15.1.1	Introduction	279
	15.1.2	Modes of operation	
	15.1.3	External signal description.	279
	15.1.4	Memory map and register descriptions	279
	15.1.5	Functional description.	280
15.2	Usage (Guide	280
	15.2.1	FAU Features	281
	15.2.2	FAU Configuration	281

Chapter 16 Flash Memory Module (FTFE)

16.1	Chip-sp	ecific Information for this Module	283
16.2	Introduc	tion	283
	16.2.1	Features	284
	16.2.2	Block diagram	286
	16.2.3	Glossary	286
16.3	Externa	signal description	288
16.4	Memory	map and registers	289
	16.4.1	Flash configuration field description.	289
	16.4.2	Program flash 0 IFR map.	289
	16.4.3	Data flash 0 IFR map.	290
	16.4.4	Register descriptions.	293
16.5	Functional Description.		309
	16.5.1	Flash Protection.	309
	16.5.2	Flash Access Protection.	311
	16.5.3	FlexNVM Description.	312
	16.5.4	Interrupts.	316
	16.5.5	Flash Operation in Low-Power Modes.	317
	16.5.6	Flash memory reads and ignored writes.	317
	16.5.7	Read while write (RWW)	317
	16.5.8	Flash Program and Erase.	318
	16.5.9	FTFE Command Operations.	318
	16.5.10	Margin Read Commands.	325
	16.5.11	Flash command descriptions.	326
	16.5.12	Security	351
16.6	Reset Se	equence	354
16.7	Usage C	iuide	355

Chapter 17

Section number		imber Title	Page
		Clock Distribution	
17.1	Introduc	ction	357
17.2	High-Le	evel clocking diagram	358
17.3	Clock d	efinitions	358
17.4	Typical	Clock Configuration.	359
	17.4.1	Default start-up clock	359
	17.4.2	VLPR mode clocking	360
17.5	Clock C	Gating	360
17.6	Module	clocks	360
	17.6.1	LPO clock distribution.	362
	17.6.2	EWM clocks	362
	17.6.3	WDOG Clocking Information	362
	17.6.4	ADC Clocking Information.	363
	17.6.5	PDB Clock Options	364
	17.6.6	FTM Clocking Information	364
	17.6.7	LPTMR prescaler/glitch filter clocking options	365
	17.6.8	RTC Clocking Information	365
	17.6.9	TSI Clocking Information	366
	17.6.10	Module Clocking Information for LPUART, LPSPI, LPI2C, FlexIO and LPIT	366
		Chapter 18 System Clock Generator (SCG)	
18.1	Chip-sp	ecific information for this module	369
	18.1.1	Instantiation Information.	369
18.2	Introduc	ction	372
	18.2.1	Features.	372
18.3	Memory	y Map/Register Definition	373
	18.3.1	Version ID Register (SCG_VERID)	374
	18.3.2	Parameter Register (SCG_PARAM)	374
	18.3.3	Clock Status Register (SCG_CSR)	375

Sec	tion nu	mber Title	Page
	18.3.4	Run Clock Control Register (SCG_RCCR)	377
	18.3.5	VLPR Clock Control Register (SCG_VCCR)	379
	18.3.6	SCG CLKOUT Configuration Register (SCG_CLKOUTCNFG)	381
	18.3.7	System OSC Control Status Register (SCG_SOSCCSR)	382
	18.3.8	System OSC Divide Register (SCG_SOSCDIV)	
	18.3.9	System Oscillator Configuration Register (SCG_SOSCCFG)	385
	18.3.10	Slow IRC Control Status Register (SCG_SIRCCSR)	387
	18.3.11	Slow IRC Divide Register (SCG_SIRCDIV)	388
	18.3.12	Slow IRC Configuration Register (SCG_SIRCCFG)	389
	18.3.13	Fast IRC Control Status Register (SCG_FIRCCSR)	390
	18.3.14	Fast IRC Divide Register (SCG_FIRCDIV)	392
	18.3.15	Fast IRC Configuration Register (SCG_FIRCCFG)	393
	18.3.16	Fast IRC Trim Configuration Register (SCG_FIRCTCFG)	394
	18.3.17	Fast IRC Status Register (SCG_FIRCSTAT)	395
	18.3.18	Low Power FLL Control Status Register (SCG_LPFLLCSR)	396
	18.3.19	Low Power FLL Divide Register (SCG_LPFLLDIV)	398
	18.3.20	Low Power FLL Configuration Register (SCG_LPFLLCFG)	399
	18.3.21	Low Power FLL Trim Configuration Register (SCG_LPFLLTCFG)	400
	18.3.22	Low Power FLL Status Register (SCG_LPFLLSTAT)	401
18.4	Function	nal description	402
	18.4.1	SCG Clock Mode Transitions	402
		Chapter 19 RTC Oscillator (OSC32)	
19.1	Introduc	ction	405
	19.1.1	Features and Modes.	
	19.1.2	Block Diagram	405
19.2	RTC Sig	406	
	19.2.1	EXTAL32 — Oscillator Input	406
	19.2.2	XTAL32 — Oscillator Output	406

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Sec	tion number	Title	
19.3	External Crystal Connections		407
19.4	Memory Map/Register Descriptions		407
	19.4.1 RTC Oscillator Control Register (C	OSC32_CR)	407
19.5	Functional Description		408
19.6	Reset Overview		409
19.7	Interrupts		409
	Periphera	Chapter 20 al Clock Controller (PCC)	
20.1	Chip-specific information for this module		411
	20.1.1 Information of PCC on this device.		411
20.2	Introduction		411
	20.2.1 Features		411
20.3	Functional description		412
20.4	Memory map and register definition		413
	20.4.1 PCC Register Descriptions		413
		Chapter 21 Reset and Boot	
21.1	Introduction		459
21.2	Reset		460
	21.2.1 Power-on reset (POR)		460
	21.2.2 System resets		460
	21.2.3 MCU Resets		463
	21.2.4 Reset Pin		
21.3	Boot		464
	21.3.1 Boot options		
	21.3.2 Boot sequence		466
	Kine	Chapter 22 etis ROM Bootloader	
22.1	Chip-specific information for this module		469
	22.1.1 Boot ROM Configuration		469
	Kinetis KE1xZ256 Sub-	-Family Reference Manual, Rev. 3, 07/	2018

Sec	tion nu	umber Title	Page
22.2	Introdu	ection	470
22.3	Functional Description.		471
	22.3.1	Memory Maps	471
	22.3.2	The Kinetis Bootloader Configuration Area (BCA)	472
	22.3.3	Start-up Process	474
	22.3.4	Clock Configuration.	476
	22.3.5	Bootloader Entry Point / API Tree	477
	22.3.6	Bootloader Protocol	
	22.3.7	Bootloader Packet Types	481
	22.3.8	Bootloader Command API	487
	22.3.9	Bootloader Exit state	500
22.4	Kinetis	Flash Driver API	500
	22.4.1	Flash Driver Entry Point	500
	22.4.2	Flash driver API Tree	501
	22.4.3	Quick demo using Kinetis Flash Driver API	502
	22.4.4	Flash driver data structures	
	22.4.5	Flash driver API.	504
22.5	Peripherals Supported.		518
	22.5.1	I2C Peripheral	518
	22.5.2	SPI Peripheral	
	22.5.3	UART Peripheral	
22.6	Get/Set	tProperty Command Properties	525
	22.6.1	Property Definitions	527
22.7	Kinetis	Bootloader Status Error Codes	528
		Chapter 23 Reset Control Module (RCM)	
23.1	Chip-s ₁	pecific information for this module	531
	23.1.1	Instantiation Information.	531
23.2	Introdu	action	531

Sec	Section number Title		Page	
23.3	Reset memory map and register descriptions		532	
	23.3.1	Version ID Register (RCM_VERID)	532	
	23.3.2	Parameter Register (RCM_PARAM)	534	
	23.3.3	System Reset Status Register (RCM_SRS)	536	
	23.3.4	Reset Pin Control register (RCM_RPC)	539	
	23.3.5	Mode Register (RCM_MR)	540	
	23.3.6	Force Mode Register (RCM_FM)	541	
	23.3.7	Sticky System Reset Status Register (RCM_SSRS)	542	
	23.3.8	System Reset Interrupt Enable Register (RCM_SRIE)	544	
		Chapter 24 Power Management		
24.1	Introduc	ction	547	
24.2	Power M	Modes Description	548	
	24.2.1	Run mode	549	
	24.2.2	Wait mode	550	
	24.2.3	Stop mode		
	24.2.4	Power domains	553	
	24.2.5	Entering and exiting power modes	554	
24.3	Power n	node transitions	554	
24.4	Power n	nodes shutdown sequencing	555	
24.5	Module operation in low power modes		556	
	24.5.1	Peripheral doze	559	
24.6	Low-pov	wer wake-up sources	560	
24.7	Power si	upply supervisor	560	
		Chapter 25 System Mode Controller (SMC)		
25.1	Introduc	ction	563	
25.2	Modes o	of operation	563	
25.3	Memory map and register descriptions			

Section number Title		Page	
	25.3.1	SMC Version ID Register (SMC_VERID)	565
	25.3.2	SMC Parameter Register (SMC_PARAM)	566
	25.3.3	Power Mode Protection register (SMC_PMPROT)	567
	25.3.4	Power Mode Control register (SMC_PMCTRL)	569
	25.3.5	Stop Control Register (SMC_STOPCTRL)	570
	25.3.6	Power Mode Status register (SMC_PMSTAT)	572
25.4	Functio	nal description.	572
	25.4.1	Power mode transitions.	572
	25.4.2	Power mode entry/exit sequencing	574
	25.4.3	Run modes	576
	25.4.4	Wait modes	578
	25.4.5	Stop modes	579
	25.4.6	Debug in low power modes	580
		Chapter 26 Power Management Controller (PMC)	
26.1	Chip-sp	pecific Information for this Module	581
26.2	Introdu	ction	581
26.3	Feature	S	581
26.4	Modes	581	
	26.4.1	Full Performance Mode (FPM)	581
	26.4.2	Low Power Mode (LPM)	582
26.5	Low Vo	oltage Detect (LVD) System	582
	26.5.1	Low Voltage Reset (LVR) Operation	582
	26.5.2	LVD Interrupt Operation.	583
	26.5.3	Low-voltage warning (LVW) interrupt operation	583
26.6	Memor	y Map and Register Definition	583
	26.6.1	Low Voltage Detect Status and Control 1 Register (PMC_LVDSC1)	584
	26.6.2	Low Voltage Detect Status and Control 2 Register (PMC_LVDSC2)	585
	26.6.3	Regulator Status and Control Register (PMC_REGSC)	586

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Sec	tion nu	ımber Title	Page
	26.6.4	Low Power Oscillator Trim Register (PMC_LPOTRIM)	587
		Chapter 27 Security	
27.1	Introdu	ction	589
27.2	Flash se	ecurity feature summary	589
	27.2.1	Flash security byte	589
	27.2.2	Flash access protection (FAC)	590
27.3	Security	y hardware accelerators	590
	27.3.1	CRC	590
27.4	General	security features.	591
	27.4.1	Unique ID.	591
	27.4.2	Program Once Field	591
		Chapter 28 External Watchdog Monitor (EWM)	
28.1	Introdu	ction	593
	28.1.1	Features	593
	28.1.2	Modes of Operation	594
	28.1.3	Block Diagram	595
28.2	EWM S	Signal Descriptions	596
28.3	Memor	y Map/Register Definition	596
	28.3.1	Control Register (EWM_CTRL)	596
	28.3.2	Service Register (EWM_SERV)	597
	28.3.3	Compare Low Register (EWM_CMPL)	597
	28.3.4	Compare High Register (EWM_CMPH)	598
	28.3.5	Clock Prescaler Register (EWM_CLKPRESCALER)	599
28.4	Functio	nal Description	599
	28.4.1	The EWM_out Signal	599
	28.4.2	The EWM_in Signal	600
	28.4.3	EWM Counter	601

Section number		imber Title	Page
	28.4.4	EWM Compare Registers	601
	28.4.5	EWM Refresh Mechanism.	601
	28.4.6	EWM Interrupt	602
	28.4.7	Counter clock prescaler	602
28.5	Usage Guide		602
	28.5.1	EWM low-power modes	602
	28.5.2	EWM_out pin state in low power modes	603
	28.5.3	Example code	603
		Chapter 29 Watchdog timer (WDOG)	
29.1	Chip-sp	pecific information for this module	605
	29.1.1	WDOG Clocking Information	
	29.1.2	WDOG low-power modes	
29.2	Introdu	606	
	29.2.1	Features	606
	29.2.2	Block diagram	607
29.3	Memor	y map and register definition	607
	29.3.1	Watchdog Control and Status Register (WDOG_CS)	608
	29.3.2	Watchdog Counter Register (WDOG_CNT)	611
	29.3.3	Watchdog Timeout Value Register (WDOG_TOVAL)	611
	29.3.4	Watchdog Window Register (WDOG_WIN)	612
29.4	Functio	nal description	613
	29.4.1	Clock source.	613
	29.4.2	Watchdog refresh mechanism.	614
	29.4.3	Configuring the Watchdog	616
	29.4.4	Using interrupts to delay resets.	617
	29.4.5	Backup reset	617
	29.4.6	Functionality in debug and low-power modes	618
	29.4.7	Fast testing of the watchdog	618

Sec	tion nu	umber Title	Page
29.5	Applica	ation Information	619
	29.5.1	Disable Watchdog	620
	29.5.2	Configure Watchdog	620
	29.5.3	Refreshing the Watchdog	621
		Chapter 30 Cyclic Redundancy Check (CRC)	
30.1	Introdu	ction	623
	30.1.1	Features	623
	30.1.2	Block diagram	623
	30.1.3	Modes of operation	
30.2	Memory map and register descriptions		624
	30.2.1	CRC Data register (CRC_DATA)	625
	30.2.2	CRC Polynomial register (CRC_GPOLY)	626
	30.2.3	CRC Control register (CRC_CTRL)	626
30.3	Function	onal description	627
	30.3.1	CRC initialization/reinitialization	627
	30.3.2	CRC calculations	628
	30.3.3	Transpose feature	629
	30.3.4	CRC result complement	631
30.4	Usage (Guide	631
	30.4.1	32-bit POSIX CRC	632
	30.4.2	16-bit KERMIT CRC	633
		Chapter 31 Debug	
31.1	Introdu	ction	635
31.2	Debug	port pin descriptions	635
31.3	SWD s	tatus and control registers	635
	31.3.1	MDM-AP status register.	637
	31.3.2	MDM-AP Control register	638

Sect	tion nu	ımber Title	Page
31.4	Debug	resets	639
31.5	Micro 7	Γrace Buffer (MTB)	639
31.6	Debug	in low-power modes	640
31.7	Debug	and security	640
		Chapter 32 Micro Trace Buffer (MTB)	
32.1	Introdu	ction	641
	32.1.1	Overview	641
	32.1.2	Features	644
	32.1.3	Modes of operation	645
32.2	Externa	ıl signal description	645
32.3	Memor	y map and register definition	646
	32.3.1	MTB_RAM Memory Map	646
	32.3.2	MTB_DWT Memory Map	658
	32.3.3	System ROM Memory Map	668
32.4	Usage (Guide	672
	32.4.1	ARM reference	672
		Chapter 33 Signal Multiplexing and Pin Assignmen	
33.1		ction	
33.2			
	33.2.1	KE1xZ Signal Multiplexing and Pin Assignments	
	33.2.2	Pin properties	679
	33.2.3	Pinout diagram	682
33.3	Module	e Signal Description Tables	684
	33.3.1	Core Modules	
	33.3.2	System Modules	685
	33.3.3	Clock Modules	685
	33.3.4	Analog	686

Sec	tion nu	ımber Title	Page
	33.3.5	Timer Modules	686
	33.3.6	Communication Interfaces	687
	33.3.7	Human-Machine Interfaces (HMI)	688
		Chapter 34 Port Control and Interrupts (PORT)	
34.1	Chip-specific information for this module		691
	34.1.1	I/O pin structure.	691
	34.1.2	Port control and interrupt module features	
	34.1.3	Application-related Information.	
34.2	Introdu	ction	693
34.3	Overvie	693	
	34.3.1	Features	693
	34.3.2	Modes of operation	694
34.4	Externa	ıl signal description	695
34.5	Detaile	d signal description	695
34.6	Memory map and register definition		695
	34.6.1	Pin Control Register n (PORTx_PCRn)	702
	34.6.2	Global Pin Control Low Register (PORTx_GPCLR)	705
	34.6.3	Global Pin Control High Register (PORTx_GPCHR)	705
	34.6.4	Interrupt Status Flag Register (PORTx_ISFR)	706
	34.6.5	Digital Filter Enable Register (PORTx_DFER)	706
	34.6.6	Digital Filter Clock Register (PORTx_DFCR)	707
	34.6.7	Digital Filter Width Register (PORTx_DFWR)	707
34.7	Functional description.		708
	34.7.1	Pin control.	708
	34.7.2	Global pin control	709
	34.7.3	External interrupts.	709
	34.7.4	Digital filter	710
		Chapter 35	

Sec	Section number Title		Page
		General-Purpose Input/Output (GPIO)	
35.1	Chip-sp	pecific information for this module	713
	35.1.1	Instantiation Information.	713
	35.1.2	GPIO accessibility in the memory map	713
35.2	Introdu	Introduction	
	35.2.1	Features	714
	35.2.2	Modes of operation	714
	35.2.3	GPIO signal descriptions	714
35.3	Memor	y map and register definition	715
	35.3.1	Port Data Output Register (GPIOx_PDOR)	717
	35.3.2	Port Set Output Register (GPIOx_PSOR)	718
	35.3.3	Port Clear Output Register (GPIOx_PCOR)	718
	35.3.4	Port Toggle Output Register (GPIOx_PTOR)	719
	35.3.5	Port Data Input Register (GPIOx_PDIR)	719
	35.3.6	Port Data Direction Register (GPIOx_PDDR)	720
35.4	FGPIO	FGPIO memory map and register definition	
	35.4.1	Port Data Output Register (FGPIOx_PDOR)	722
	35.4.2	Port Set Output Register (FGPIOx_PSOR)	722
	35.4.3	Port Clear Output Register (FGPIOx_PCOR)	
	35.4.4	Port Toggle Output Register (FGPIOx_PTOR)	723
	35.4.5	Port Data Input Register (FGPIOx_PDIR)	724
	35.4.6	Port Data Direction Register (FGPIOx_PDDR)	724
35.5	Function	Functional description.	
	35.5.1	General-purpose input.	725
	35.5.2	General-purpose output	725
	35.5.3	IOPORT	725
		Chapter 36	
36.1	Chip-sr	Analog-to-Digital Converter (ADC) Decific information for this module	727
	r T		

Section nu		mber Title	Page
	36.1.1	Instantiation information	727
	36.1.2	ADC Clocking Information.	729
	36.1.3	Inter-connectivity Information	730
	36.1.4	Application-related Information.	731
36.2	Introduction		736
	36.2.1	Features.	736
	36.2.2	Block diagram	737
36.3	ADC sig	gnal descriptions	738
	36.3.1	Analog Power (VDDA)	739
	36.3.2	Analog Ground (VSSA)	739
	36.3.3	Voltage Reference Select	739
	36.3.4	Analog Channel Inputs (ADx)	740
36.4	Memory	map and register definitions	740
	36.4.1	ADC Status and Control Register 1 (ADCx_SC1n)	742
	36.4.2	ADC Configuration Register 1 (ADCx_CFG1)	745
	36.4.3	ADC Configuration Register 2 (ADCx_CFG2)	746
	36.4.4	ADC Data Result Registers (ADCx_Rn)	747
	36.4.5	Compare Value Registers (ADCx_CVn)	748
	36.4.6	Status and Control Register 2 (ADCx_SC2)	749
	36.4.7	Status and Control Register 3 (ADCx_SC3)	751
	36.4.8	BASE Offset Register (ADCx_BASE_OFS)	752
	36.4.9	ADC Offset Correction Register (ADCx_OFS)	752
	36.4.10	USER Offset Correction Register (ADCx_USR_OFS)	753
	36.4.11	ADC X Offset Correction Register (ADCx_XOFS)	754
	36.4.12	ADC Y Offset Correction Register (ADCx_YOFS)	754
	36.4.13	ADC Gain Register (ADCx_G)	
	36.4.14	ADC User Gain Register (ADCx_UG)	755
	36.4.15	ADC General Calibration Value Register S (ADCx_CLPS)	755
	36.4.16	ADC Plus-Side General Calibration Value Register 3 (ADCx_CLP3)	756

Sect	tion nu	mber Title	Page
	36.4.17	ADC Plus-Side General Calibration Value Register 2 (ADCx_CLP2)	757
	36.4.18	ADC Plus-Side General Calibration Value Register 1 (ADCx_CLP1)	757
	36.4.19	ADC Plus-Side General Calibration Value Register 0 (ADCx_CLP0)	758
	36.4.20	ADC Plus-Side General Calibration Value Register X (ADCx_CLPX)	758
	36.4.21	ADC Plus-Side General Calibration Value Register 9 (ADCx_CLP9)	759
	36.4.22	ADC General Calibration Offset Value Register S (ADCx_CLPS_OFS)	760
	36.4.23	ADC Plus-Side General Calibration Offset Value Register 3 (ADCx_CLP3_OFS)	760
	36.4.24	ADC Plus-Side General Calibration Offset Value Register 2 (ADCx_CLP2_OFS)	761
	36.4.25	ADC Plus-Side General Calibration Offset Value Register 1 (ADCx_CLP1_OFS)	761
	36.4.26	ADC Plus-Side General Calibration Offset Value Register 0 (ADCx_CLP0_OFS)	761
	36.4.27	ADC Plus-Side General Calibration Offset Value Register X (ADCx_CLPX_OFS)	762
	36.4.28	ADC Plus-Side General Calibration Offset Value Register 9 (ADCx_CLP9_OFS)	762
36.5	Function	nal description	763
	36.5.1	Clock select and divide control	763
	36.5.2	Voltage reference selection	764
	36.5.3	Hardware trigger and channel selects	764
	36.5.4	Conversion control.	765
	36.5.5	Automatic compare function	769
	36.5.6	Calibration function.	770
	36.5.7	User-defined offset function.	771
	36.5.8	MCU wait mode operation.	772
	36.5.9	MCU Normal Stop mode operation.	773
36.6	Usage C	uide	773
	36.6.1	ADC module initialization sequence	773
	36.6.2	Pseudo-code example	774
	36.6.3	Calibration.	775
	36.6.4	Application hints	776
	36.6.5	DMA Support on ADC	776
	36.6.6	ADC low-power modes	776

Sec	tion nu	umber Title	Page
	36.6.7	ADC Trigger Concept – Use Case	777
	36.6.8	ADC self-test and calibration scheme	778
		Chapter 37 Comparator (CMP)	
37.1	Chip-sp	pecific information for this module	779
	37.1.1	Instantiation information	779
	37.1.2	CMP Clocking Information	
	37.1.3	Inter-connectivity Information.	781
	37.1.4	Application-related Information.	
37.2	Introdu	ction	784
37.3	Feature	es	784
	37.3.1	CMP features	784
	37.3.2	8-bit DAC key features	
	37.3.3	ANMUX key features	785
37.4	CMP, I	DAC, and ANMUX diagram	786
37.5	CMP b	lock diagram	787
37.6	CMP p	in descriptions	788
	37.6.1	External pins	
37.7	CMP fu	unctional modes	
	37.7.1	Disabled mode (# 1)	791
	37.7.2	Continuous mode (#s 2A & 2B)	
	37.7.3	Sampled, Non-Filtered mode (#s 3A & 3B)	792
	37.7.4	Sampled, Filtered mode (#s 4A & 4B)	
	37.7.5	Windowed mode (#s 5A & 5B)	
	37.7.6	Windowed/Resampled mode (# 6)	797
	37.7.7	Windowed/Filtered mode (#7)	798
37.8	Memor	ry map/register definitions	799
	37.8.1	CMP Control Register 0 (CMPx_C0)	799
	37.8.2	CMP Control Register 1 (CMPx_C1)	

Sect	ion nu	imber Title	Page
	37.8.3	CMP Control Register 2 (CMPx_C2)	806
37.9	CMP fu	unctional description.	808
	37.9.1	Initialization	809
	37.9.2	Low-pass filter	809
37.10	Interrup	ots	811
37.11	DMA su	upport	812
37.12	DAC fu	unctional description.	812
	37.12.1	Digital-to-analog converter block diagram.	812
	37.12.2	DAC resets	813
	37.12.3	DAC clocks	813
	37.12.4	DAC interrupts	813
37.13	Trigger	mode	813
37.14	Usage C	Guide	816
	37.14.1	Zero Crossing Detection	816
	37.14.2	Window Mode	817
	37.14.3	Round Robin Mode	817
		Chapter 38 Programmable Delay Block (PDB)	
38.1	Chip-sp	pecific Information for this Module	821
	38.1.1	Instantiation Information.	821
	38.1.2	PDB Clocking Information.	821
	38.1.3	Inter-connectivity Information.	822
38.2	Introduc	ction	824
	38.2.1	Features	824
	38.2.2	Implementation	
	38.2.3	Back-to-back acknowledgment connections	825
	38.2.4	Block diagram	825
	38.2.5	Modes of operation	
38.3	PDB sig	gnal descriptions	827

Sec	tion nu	imber Title	Page
38.4	Memory	y map and register definition	827
	38.4.1	Status and Control register (PDBx_SC)	829
	38.4.2	Modulus register (PDBx_MOD)	832
	38.4.3	Counter register (PDBx_CNT)	832
	38.4.4	Interrupt Delay register (PDBx_IDLY)	833
	38.4.5	Channel n Control register 1 (PDBx_CHnC1)	833
	38.4.6	Channel n Status register (PDBx_CHnS)	834
	38.4.7	Channel n Delay 0 register (PDBx_CHnDLY0)	835
	38.4.8	Channel n Delay 1 register (PDBx_CHnDLY1)	836
	38.4.9	Pulse-Out n Enable register (PDBx_POEN)	836
	38.4.10	Pulse-Out n Delay register (PDBx_POnDLY)	837
38.5	Function	nal description.	837
	38.5.1	PDB pre-trigger and trigger outputs	837
	38.5.2	PDB trigger input source selection.	839
	38.5.3	Pulse-Out's	840
	38.5.4	Updating the delay registers	841
	38.5.5	Interrupts	843
	38.5.6	DMA	843
38.6	Applica	tion information	843
	38.6.1	Impact of using the prescaler and multiplication factor on timing resolution	843
38.7	Usage C	Guide	844
	38.7.1	Using PDB to precisely control ADC conversion	844
		Chapter 39 FlexTimer Module (FTM)	
39.1	Chip-sp	pecific information for this module	845
	39.1.1	Instantiation Information	845
	39.1.2	FTM Clocking Information.	845
	39.1.3	Inter-connectivity Information.	846
39.2	Introduc	ction	850

Sec	tion nu	mber Title	Page
	39.2.1	FlexTimer philosophy	850
	39.2.2	Features	851
	39.2.3	Modes of operation	853
	39.2.4	Block Diagram	853
39.3	FTM sig	gnal descriptions	855
39.4	Memory	map and register definition	855
	39.4.1	Memory map	855
	39.4.2	Register descriptions.	856
	39.4.3	Status And Control (FTMx_SC)	862
	39.4.4	Counter (FTMx_CNT)	865
	39.4.5	Modulo (FTMx_MOD)	865
	39.4.6	Channel (n) Status And Control (FTMx_CnSC)	867
	39.4.7	Channel (n) Value (FTMx_CnV)	869
	39.4.8	Counter Initial Value (FTMx_CNTIN)	869
	39.4.9	Capture And Compare Status (FTMx_STATUS)	870
	39.4.10	Features Mode Selection (FTMx_MODE)	
	39.4.11	Synchronization (FTMx_SYNC)	874
	39.4.12	Initial State For Channels Output (FTMx_OUTINIT)	876
	39.4.13	Output Mask (FTMx_OUTMASK)	878
	39.4.14	Function For Linked Channels (FTMx_COMBINE)	880
	39.4.15	Deadtime Configuration (FTMx_DEADTIME)	884
	39.4.16	FTM External Trigger (FTMx_EXTTRIG)	885
	39.4.17	Channels Polarity (FTMx_POL)	887
	39.4.18	Fault Mode Status (FTMx_FMS)	890
	39.4.19	Input Capture Filter Control (FTMx_FILTER)	
	39.4.20	Fault Control (FTMx_FLTCTRL)	
	39.4.21	Quadrature Decoder Control And Status (FTMx_QDCTRL)	896
	39.4.22	Configuration (FTMx_CONF)	898
	39.4.23	FTM Fault Input Polarity (FTMx_FLTPOL)	899

Sect	ion nu	mber Title	Page
	39.4.24	Synchronization Configuration (FTMx_SYNCONF)	900
	39.4.25	FTM Inverting Control (FTMx_INVCTRL)	902
	39.4.26	FTM Software Output Control (FTMx_SWOCTRL)	903
	39.4.27	FTM PWM Load (FTMx_PWMLOAD)	906
	39.4.28	Half Cycle Register (FTMx_HCR)	908
	39.4.29	Mirror of Modulo Value (FTMx_MOD_MIRROR)	908
	39.4.30	Mirror of Channel (n) Match Value (FTMx_CnV_MIRROR)	909
39.5	Function	nal description	909
	39.5.1	Clock source	910
	39.5.2	Prescaler	911
	39.5.3	Counter	911
	39.5.4	Channel Modes	917
	39.5.5	Input Capture mode	919
	39.5.6	Output Compare mode	922
	39.5.7	Edge-Aligned PWM (EPWM) mode	924
	39.5.8	Center-Aligned PWM (CPWM) mode	925
	39.5.9	Combine mode	927
	39.5.10	Complementary Mode	935
	39.5.11	Registers updated from write buffers	936
	39.5.12	PWM synchronization.	938
	39.5.13	Inverting	954
	39.5.14	Software Output Control Mode	955
	39.5.15	Deadtime insertion.	957
	39.5.16	Output mask	960
	39.5.17	Fault control	960
	39.5.18	Polarity Control	964
	39.5.19	Initialization	965
	39.5.20	Features priority	965
	39.5.21	External Trigger.	966

Sec	tion nu	ımber Title	Page
	39.5.22	Channel trigger output	967
	39.5.23	Initialization trigger	968
	39.5.24	Capture Test Mode	971
	39.5.25	DMA	972
	39.5.26	Dual Edge Capture mode	973
	39.5.27	Quadrature Decoder mode	980
	39.5.28	Debug mode	985
	39.5.29	Reload Points.	
	39.5.30	Global Load	989
	39.5.31	Global time base (GTB)	990
	39.5.32	Output Logic	991
	39.5.33	Dithering	992
39.6	Reset o	verview	1001
39.7	FTM In	nterrupts	
	39.7.1	Timer Overflow Interrupt	
	39.7.2	Reload Point Interrupt	
	39.7.3	Channel (n) Interrupt	1003
	39.7.4	Fault Interrupt.	
39.8	Initializ	zation Procedure	1004
39.9	Usage (Guide	1005
	39.9.1	FTM Interrupts.	
	39.9.2	FTM Hall sensor support	
	39.9.3	FTM Modulation Implementation	
	39.9.4	FTM Global Time Base	
	39.9.5	FTM BDM and debug halt mode	1008
		Chapter 40 Low-power Periodic Interrupt Timer (LP	IT)
40.1	Chip-sr	pecific Information for this Module	
	40.1.1	Instantiation Information	
			1007

Sec	tion nu	ımber Title	Page
	40.1.2	LPIT Clocking Information	1009
	40.1.3	Inter-connectivity Information	1009
40.2	Introdu	ction	1010
	40.2.1	Overview	1010
	40.2.2	Block Diagram.	1011
40.3	Modes	of operation	1012
40.4	Memor	y Map and Registers	1013
	40.4.1	Version ID Register (LPITx_VERID)	1014
	40.4.2	Parameter Register (LPITx_PARAM)	1014
	40.4.3	Module Control Register (LPITx_MCR)	1015
	40.4.4	Module Status Register (LPITx_MSR)	1016
	40.4.5	Module Interrupt Enable Register (LPITx_MIER)	1017
	40.4.6	Set Timer Enable Register (LPITx_SETTEN)	1018
	40.4.7	Clear Timer Enable Register (LPITx_CLRTEN)	1019
	40.4.8	Timer Value Register (LPITx_TVALn)	1020
	40.4.9	Current Timer Value (LPITx_CVALn)	1021
	40.4.10	Timer Control Register (LPITx_TCTRLn)	1022
40.5	Functio	nal description	1023
	40.5.1	Initialization	
	40.5.2	Timer Modes	1024
	40.5.3	Trigger Control for Timers	
	40.5.4	Channel Chaining	1026
40.6	Usage (Guide	1026
	40.6.1	Periodic timer/counter.	1026
	40.6.2	LPIT/ADC Trigger	1027
		Chapter 41 Pulse Width Timer (PWT)	
41.1	Chip-sp	pecific information for this module	1031
	41.1.1	Instantiation Information.	1031

Sec	tion nu	ımber Title	Page
	41.1.2	PWT Clocking Information	1031
	41.1.3	Inter-connectivity Information.	1032
41.2	Introdu	ction	1033
	41.2.1	Features	1033
	41.2.2	Modes of operation	
	41.2.3	Block diagram.	1034
41.3	Externa	l signal description	1035
	41.3.1	Overview	1035
	41.3.2	PWTIN[3:0] — pulse width timer capture inputs	1036
	41.3.3	ALTCLK— alternative clock source for counter	1036
41.4	Memor	y Map and Register Descriptions	1036
	41.4.1	Pulse Width Timer Control and Status Register (PWT_CS)	1037
	41.4.2	Pulse Width Timer Control Register (PWT_CR)	1038
	41.4.3	Pulse Width Timer Positive Pulse Width Register: High (PWT_PPH)	1039
	41.4.4	Pulse Width Timer Positive Pulse Width Register: Loq (PWT_PPL)	1039
	41.4.5	Pulse Width Timer Negative Pulse Width Register: High (PWT_NPH)	1040
	41.4.6	Pulse Width Timer Negative Pulse Width Register: Low (PWT_NPL)	1040
	41.4.7	Pulse Width Timer Counter Register: High (PWT_CNTH)	1041
	41.4.8	Pulse Width Timer Counter Register: Low (PWT_CNTL)	1041
41.5	Functio	nal description.	1041
	41.5.1	PWT counter and PWT clock pre-scaler.	1041
	41.5.2	Edge detection and capture control.	1042
41.6	Reset o	verview	1046
	41.6.1	Description of reset operation.	1046
41.7	Interrup	ots	1047
	41.7.1	Description of interrupt operation	1047
	41.7.2	Application examples	1048
41.8	Initializ	cation/Application information	1049
41.9	Usage (Guide	1050

Sec	tion nu	mber Title	Page
	41.9.1	Edge detection, capture control and period measurement	
		Chapter 42 Low Power Timer (LPTMR)	
42.1	Chip-sp	ecific information for this module	1053
	42.1.1	Instantiation Information.	1053
	42.1.2	LPTMR Clocking Information	1053
	42.1.3	Inter-connectivity Information	1054
42.2	Introduc	ction	1055
	42.2.1	Features	
	42.2.2	Modes of operation	
42.3	LPTMR	signal descriptions	
	42.3.1	Detailed signal descriptions.	
42.4	Memory	y map and register definition	1056
	42.4.1	Low Power Timer Control Status Register (LPTMRx_CSR)	1057
	42.4.2	Low Power Timer Prescale Register (LPTMRx_PSR)	1058
	42.4.3	Low Power Timer Compare Register (LPTMRx_CMR)	1060
	42.4.4	Low Power Timer Counter Register (LPTMRx_CNR)	1060
42.5	Function	nal description	1060
	42.5.1	LPTMR power and reset	1061
	42.5.2	LPTMR clocking	1061
	42.5.3	LPTMR prescaler/glitch filter	1061
	42.5.4	LPTMR compare	1063
	42.5.5	LPTMR counter	
	42.5.6	LPTMR hardware trigger	1064
	42.5.7	LPTMR interrupt	1064
42.6	Usage C	Guide	1064
	42.6.1	Time Counter mode	
	42.6.2	Pulse Counter mode	
		Chapter 43	

Sec	tion nu	ımber Title	Page
		Real Time Clock (SRTC)	
43.1	Chip-sp	pecific information for this module	1067
	43.1.1	RTC Instantiation.	1067
	43.1.2	RTC Clocking Information.	
	43.1.3	Inter-connectivity Information	1068
43.2	Introduction.		1069
	43.2.1	Features	1069
	43.2.2	Modes of operation	
	43.2.3	RTC signal descriptions.	1070
43.3	Registe	r definition	1070
	43.3.1	RTC Time Seconds Register (RTC_TSR)	1071
	43.3.2	RTC Time Prescaler Register (RTC_TPR)	1071
	43.3.3	RTC Time Alarm Register (RTC_TAR)	
	43.3.4	RTC Time Compensation Register (RTC_TCR)	1072
	43.3.5	RTC Control Register (RTC_CR)	1074
	43.3.6	RTC Status Register (RTC_SR)	
	43.3.7	RTC Lock Register (RTC_LR)	1077
	43.3.8	RTC Interrupt Enable Register (RTC_IER)	1078
	43.3.9	RTC Write Access Register (RTC_WAR)	
	43.3.10	RTC Read Access Register (RTC_RAR)	
43.4	Functional description.		1082
	43.4.1	Power, clocking, and reset	
	43.4.2	Time counter	
	43.4.3	Compensation	1084
	43.4.4	Time alarm	
	43.4.5	Update mode	
	43.4.6	Register lock	
	43.4.7	Access control	1086
	43.4.8	Interrupt	1086

Section number Title		Page	
43.5	Usage G	Guide	1086
	43.5.1	Clock source information.	1086
	43.5.2	Usage examples	1086
	43.5.3	RTC_CLKOUT signal	1088
		Chapter 44 Low Power Serial Peripheral Interface (LPSPI)	
44.1	Chip-spe	ecific information for this module	1089
	44.1.1	Instantiation Information.	1089
	44.1.2	Module Clocking Information for LPUART, LPSPI, LPI2C, FlexIO and LPIT	1089
	44.1.3	Inter-connectivity Information.	1090
44.2	Introduc	tion	1091
	44.2.1	Overview	1091
	44.2.2	Features	1091
	44.2.3	Block Diagram	1092
	44.2.4	Modes of operation	1092
	44.2.5	Signal Descriptions	1093
44.3	Memory	Map and Registers	1094
	44.3.1	Version ID Register (LPSPLx_VERID)	1095
	44.3.2	Parameter Register (LPSPIx_PARAM)	1096
	44.3.3	Control Register (LPSPIx_CR)	1097
	44.3.4	Status Register (LPSPLx_SR)	1098
	44.3.5	Interrupt Enable Register (LPSPIx_IER)	1100
	44.3.6	DMA Enable Register (LPSPIx_DER)	1101
	44.3.7	Configuration Register 0 (LPSPIx_CFGR0)	1102
	44.3.8	Configuration Register 1 (LPSPIx_CFGR1)	1103
	44.3.9	Data Match Register 0 (LPSPIx_DMR0)	1105
	44.3.10	Data Match Register 1 (LPSPIx_DMR1)	1105
	44.3.11	Clock Configuration Register (LPSPIx_CCR)	1106
	44.3.12	FIFO Control Register (LPSPIx_FCR)	1107

Sect	tion nu	ımber Title	Page
	44.3.13	FIFO Status Register (LPSPIx_FSR)	1107
	44.3.14	Transmit Command Register (LPSPIx_TCR)	1108
	44.3.15	Transmit Data Register (LPSPIx_TDR)	1111
	44.3.16	Receive Status Register (LPSPLx_RSR)	1112
	44.3.17	Receive Data Register (LPSPIx_RDR)	1113
44.4	Functio	nal description	1113
	44.4.1	Clocking and Resets	1113
	44.4.2	Master Mode	1114
	44.4.3	Slave Mode	1119
	44.4.4	Interrupts and DMA Requests	1121
	44.4.5	Peripheral Triggers.	1121
		Chapter 45 Low Power Inter-Integrated Circuit (LPI2C)	
45.1	Chip-sp	pecific information for this module	1123
	45.1.1	Instantiation Information	1123
	45.1.2	Module Clocking Information for LPUART, LPSPI, LPI2C, FlexIO and LPIT	1123
	45.1.3	Inter-connectivity Information.	1124
45.2	Introdu	ction	1125
	45.2.1	Overview	1125
	45.2.2	Features	1125
	45.2.3	Block Diagram	1127
	45.2.4	Modes of operation	1127
	45.2.5	Signal Descriptions	1128
45.3	Memor	y Map and Registers	1128
	45.3.1	Version ID Register (LPI2Cx_VERID)	1131
	45.3.2	Parameter Register (LPI2Cx_PARAM)	1131
	45.3.3	Master Control Register (LPI2Cx_MCR)	1132
	45.3.4	Master Status Register (LPI2Cx_MSR)	1133
	45.3.5	Master Interrupt Enable Register (LPI2Cx_MIER)	1135

Section nur		mber Title	Page
	45.3.6	Master DMA Enable Register (LPI2Cx_MDER)	1137
	45.3.7	Master Configuration Register 0 (LPI2Cx_MCFGR0)	1138
	45.3.8	Master Configuration Register 1 (LPI2Cx_MCFGR1)	1139
	45.3.9	Master Configuration Register 2 (LPI2Cx_MCFGR2)	1141
	45.3.10	Master Configuration Register 3 (LPI2Cx_MCFGR3)	1142
	45.3.11	Master Data Match Register (LPI2Cx_MDMR)	1142
	45.3.12	Master Clock Configuration Register 0 (LPI2Cx_MCCR0)	1143
	45.3.13	Master Clock Configuration Register 1 (LPI2Cx_MCCR1)	1144
	45.3.14	Master FIFO Control Register (LPI2Cx_MFCR)	1145
	45.3.15	Master FIFO Status Register (LPI2Cx_MFSR)	1145
	45.3.16	Master Transmit Data Register (LPI2Cx_MTDR)	1146
	45.3.17	Master Receive Data Register (LPI2Cx_MRDR)	1147
	45.3.18	Slave Control Register (LPI2Cx_SCR)	1148
	45.3.19	Slave Status Register (LPI2Cx_SSR)	1149
	45.3.20	Slave Interrupt Enable Register (LPI2Cx_SIER)	1152
	45.3.21	Slave DMA Enable Register (LPI2Cx_SDER)	1153
	45.3.22	Slave Configuration Register 1 (LPI2Cx_SCFGR1)	1154
	45.3.23	Slave Configuration Register 2 (LPI2Cx_SCFGR2)	1156
	45.3.24	Slave Address Match Register (LPI2Cx_SAMR)	1157
	45.3.25	Slave Address Status Register (LPI2Cx_SASR)	1158
	45.3.26	Slave Transmit ACK Register (LPI2Cx_STAR)	1159
	45.3.27	Slave Transmit Data Register (LPI2Cx_STDR)	1159
	45.3.28	Slave Receive Data Register (LPI2Cx_SRDR)	
45.4	Function	al description	1161
	45.4.1	Clocking and Resets	1161
	45.4.2	Master Mode	1162
	45.4.3	Slave Mode	1167
	45.4.4	Interrupts and DMA Requests	1170
	45.4.5	Peripheral Triggers.	1172

Section number		umber Title	Page
45.5	Usage	Guide	1173
	1	Chapter 46 Low Power Universal Asynchronous Receiver/Transmitter (LPUAF	RT)
46.1	Chip-sp	pecific information for this module	1175
	46.1.1	Instantiation Information.	1175
	46.1.2	Module Clocking Information for LPUART, LPSPI, LPI2C, FlexIO and LPIT	1175
	46.1.3	Inter-connectivity Information.	1176
46.2	Introdu	ction	1177
	46.2.1	Features	1177
	46.2.2	Modes of operation	1178
	46.2.3	Signal Descriptions.	1179
	46.2.4	Block diagram.	1179
46.3	Registe	er definition	1181
	46.3.1	LPUART Register Descriptions.	1181
46.4	Function	onal description	1205
	46.4.1	Baud rate generation.	1205
	46.4.2	Transmitter functional description.	1206
	46.4.3	Receiver functional description.	1209
	46.4.4	Additional LPUART functions.	1216
	46.4.5	Infrared interface	1218
	46.4.6	Interrupts and status flags	1219
		Chapter 47 Flexible I/O (FlexIO)	
47.1	Chip-sp	pecific Information for this Module	1221
	47.1.1	Instantiation Information	1221
	47.1.2	FlexIO Clocking Information.	1221
	47.1.3	Inter-connectivity Information.	1222
47.2	Introdu	ction	1223
	47.2.1	Overview	1223

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Sect	tion nu	mber Title	Page
	47.2.2	Features	1224
	47.2.3	Block Diagram	1224
	47.2.4	Modes of operation	1225
	47.2.5	FlexIO Signal Descriptions.	1225
47.3	Memory	Map/Register Definition	1226
	47.3.1	Version ID Register (FLEXIO_VERID)	1228
	47.3.2	Parameter Register (FLEXIO_PARAM)	1229
	47.3.3	FlexIO Control Register (FLEXIO_CTRL)	1229
	47.3.4	Pin State Register (FLEXIO_PIN)	1230
	47.3.5	Shifter Status Register (FLEXIO_SHIFTSTAT)	1231
	47.3.6	Shifter Error Register (FLEXIO_SHIFTERR)	1232
	47.3.7	Timer Status Register (FLEXIO_TIMSTAT)	1232
	47.3.8	Shifter Status Interrupt Enable (FLEXIO_SHIFTSIEN)	1233
	47.3.9	Shifter Error Interrupt Enable (FLEXIO_SHIFTEIEN)	1234
	47.3.10	Timer Interrupt Enable Register (FLEXIO_TIMIEN)	1234
	47.3.11	Shifter Status DMA Enable (FLEXIO_SHIFTSDEN)	1235
	47.3.12	Shifter Control N Register (FLEXIO_SHIFTCTLn)	1235
	47.3.13	Shifter Configuration N Register (FLEXIO_SHIFTCFGn)	1237
	47.3.14	Shifter Buffer N Register (FLEXIO_SHIFTBUFn)	1238
	47.3.15	Shifter Buffer N Bit Swapped Register (FLEXIO_SHIFTBUFBISn)	1239
	47.3.16	Shifter Buffer N Byte Swapped Register (FLEXIO_SHIFTBUFBYSn)	1239
	47.3.17	Shifter Buffer N Bit Byte Swapped Register (FLEXIO_SHIFTBUFBBSn)	1240
	47.3.18	Timer Control N Register (FLEXIO_TIMCTLn)	1240
	47.3.19	Timer Configuration N Register (FLEXIO_TIMCFGn)	1242
	47.3.20	Timer Compare N Register (FLEXIO_TIMCMPn)	1244
47.4	Function	nal description.	1245
	47.4.1	Shifter operation	1245
	47.4.2	Timer operation.	1247
	47.4.3	Pin operation.	1249

Section number Title		umber Title	Page	
47.5	Applica	ation Information	1250	
	47.5.1	UART Transmit		
	47.5.2	UART Receive.	1251	
	47.5.3	SPI Master		
	47.5.4	SPI Slave	1255	
	47.5.5	I2C Master	1257	
	47.5.6	I2S Master	1259	
	47.5.7	I2S Slave		
47.6	Usage (Guide	1261	
		Chapter 48 Touch Sensing Input (TSI)		
48.1	Chip-sp	pecific information for this module	1269	
	48.1.1	Instantiation Information.	1269	
	48.1.2	TSI Clocking Information.	1270	
	48.1.3	Inter-connectivity Information	1270	
48.2	Introdu	ction	1271	
	48.2.1	Features	1272	
	48.2.2	Modes of operation		
	48.2.3	Block diagram	1272	
48.3	Externa	al signal description	1273	
	48.3.1	TSI[24:0]	1274	
48.4	Registe	er definition	1274	
	48.4.1	TSI General Control and Status Register (TSI_GENCS)	1275	
	48.4.2	TSI DATA Register (TSI_DATA)		
	48.4.3	TSI Threshold Register (TSI_TSHD)	1279	
	48.4.4	TSI MODE Register (TSI_MODE)	1280	
	48.4.5	TSI MUTUAL-CAP Register 0 (TSI_MUL0)	1282	
	48.4.6	TSI MUTUAL-CAP Register 1 (TSI_MUL1)	1285	
	48.4.7	TSI SINC filter Register (TSI_SINC)	1288	

Sect	ion nu	mber Title	Page
	48.4.8	TSI SSC Register 0 (TSI_SSC0)	
	48.4.9	TSI SSC Register 0 (TSI_SSC1)	
	48.4.10	TSI SSC Register 2 (TSI_SSC2)	
48.5	Function	nal description	1296
	48.5.1	Touch Sensor	1297
	48.5.2	Brief timing and Operation of TSI	1298
	48.5.3	Self-cap sensing mode	
	48.5.4	Mutual-cap sensing mode	
	48.5.5	Enable TSI module	1303
	48.5.6	Software and hardware trigger	1303
	48.5.7	Scan times	
	48.5.8	Clock setting	
	48.5.9	Reference voltage	1305
	48.5.10	End of scan.	1305
	48.5.11	Out-of-range interrupt	1306
	48.5.12	Wake up MCU from low power modes	1306
	48.5.13	DMA function support	1306
	48.5.14	Spread spectrum clocking	1306
48.6	Usage C	Guide	1309
	48.6.1	TSI Interrupts	1309
	48.6.2	How to use TSI module	1309

Chapter 1 About This Manual

1.1 Audience

This reference manual is intended for system software and hardware developers and applications programmers who want to develop products with this device. It assumes that the reader understands operating systems, microprocessor system design, and basic principles of software and hardware.

1.2 Organization

This manual has two main sets of chapters.

- 1. Chapters in the first set contain information that applies to all components on the chip.
- 2. Chapters in the second set are organized into functional groupings that detail particular areas of functionality.
 - Examples of these groupings are clocking, timers, and communication interfaces.
 - Each grouping includes chapters that provide a technical description of individual modules.

1.3 Module descriptions

Each module chapter has two main parts:

• Chip-specific: The first section, *Chip-specific [module name] information*, includes the number of module instances on the chip and possible implementation differences between the module instances, such as differences in FIFO depths or the number of

Module descriptions

channels supported. It may also include functional connections between the module instances and other modules. Read this section *first* because its content is crucial to understanding the information in other sections of the chapter.

• **General:** The subsequent sections provide general information about the module, including its signals, registers, and functional description.

NOTE

If there is a conflict between the chip-specific module information (first section) and the general module information (subsequent sections), the chip-specific information supersedes the general information.

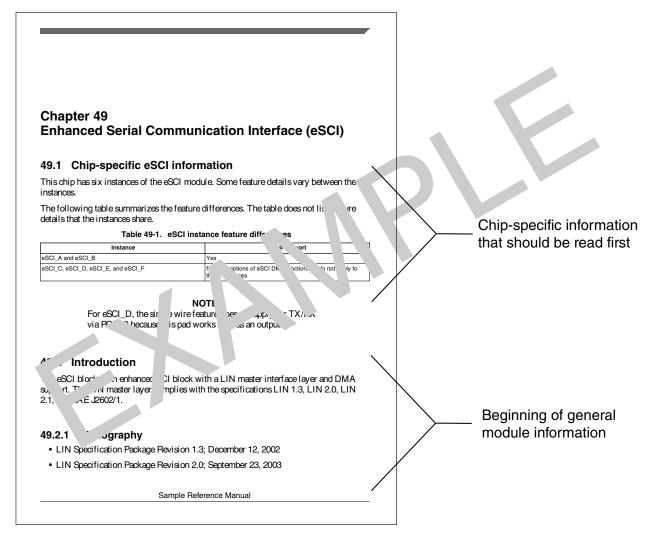


Figure 1-1. Example: chapter chip-specific information and general module information

45

1.3.1 Example: chip-specific information that supersedes content in the same chapter

The example below shows chip-specific information that supersedes general module information presented later in the chapter. In this case, the chip-specific register reset values supersede the reset values that appear in the register diagram.

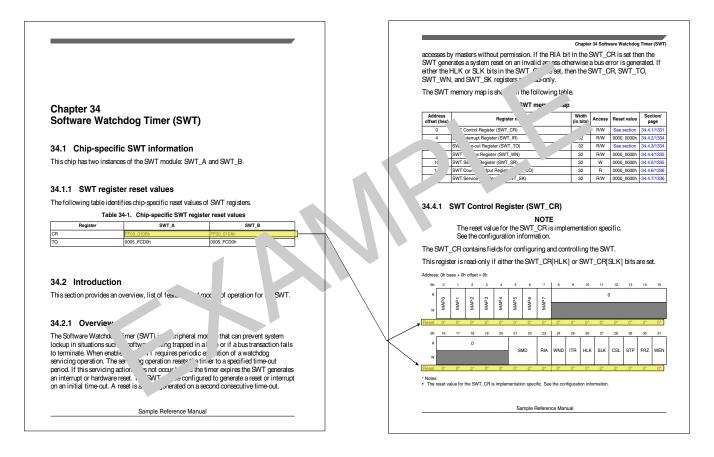


Figure 1-2. Example: chip-specific information that supersedes content in the same chapter

1.3.2 Example: chip-specific information that refers to a different chapter

The chip-specific information below refers to another chapter's chip-specific information. In this case, read both sets of chip-specific information before reading further in the chapter.

Register descriptions

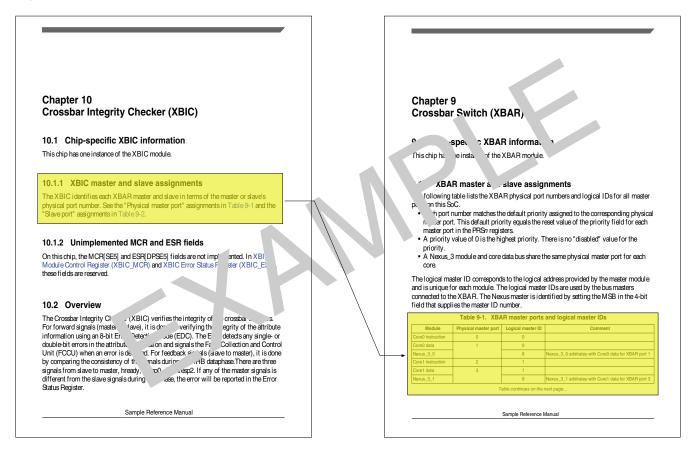


Figure 1-3. Example: chip-specific information that refers to a different chapter

1.4 Register descriptions

Module chapters present register information in:

- Memory maps including:
 - Addresses
 - The name and acronym/abbreviation of each register
 - The width of each register (in bits)
 - Each register's reset value
 - The page number on which each register is described
- Register figures
- Field-description tables
- Associated text

The register figures show the field structure using the conventions in the following figure.

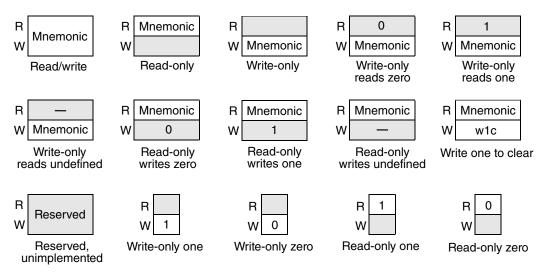


Figure 1-4. Register figure conventions

1.5 Conventions

1.5.1 Numbering systems

The following suffixes identify different numbering systems:

This suffix	Identifies a
b	Binary number. For example, the binary equivalent of the number 5 is written 101b. In some cases, binary numbers are shown with the prefix <i>0b</i> .
d	Decimal number. Decimal numbers are followed by this suffix only when the possibility of confusion exists. In general, decimal numbers are shown without a suffix.
h	Hexadecimal number. For example, the hexadecimal equivalent of the number 60 is written 3Ch. In some cases, hexadecimal numbers are shown with the prefix $0x$.

1.5.2 Typographic notation

The following typographic notation is used throughout this document:

Example	Description
placeholder, x	Items in italics are placeholders for information that you provide. Italicized text is also used for the titles of publications and for emphasis. Plain lowercase letters are also used as placeholders for single letters and numbers.
code	Fixed-width type indicates text that must be typed exactly as shown. It is used for instruction mnemonics, directives, symbols, subcommands, parameters, and operators. Fixed-width type

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Conventions

Example	Description
	is also used for example code. Instruction mnemonics and directives in text and tables are shown in all caps; for example, BSR.
SR[SCM]	A mnemonic in brackets represents a named field in a register. This example refers to the Scaling Mode (SCM) field in the Status Register (SR).
REVNO[6:4], XAD[7:0]	Numbers in brackets and separated by a colon represent either: • A subset of a register's named field
	For example, REVNO[6:4] refers to bits 6–4 that are part of the COREREV field that occupies bits 6–0 of the REVNO register.
	A continuous range of individual signals of a bus
	For example, XAD[7:0] refers to signals 7–0 of the XAD bus.

1.5.3 Special terms

The following terms have special meanings:

Term	Meaning	
asserted	Refers to the state of a signal as follows: • An active-high signal is asserted when high (1). • An active-low signal is asserted when low (0).	
deasserted	Refers to the state of a signal as follows: • An active-high signal is deasserted when low (0). • An active-low signal is deasserted when high (1). In some cases, deasserted signals are described as negated.	
reserved	Refers to a memory space, register, field, or programming setting. Writes to a reserved location can result in unpredictable functionality or behavior. • Do not modify the default value of a reserved programming setting, such as the reset value of a reserved register field. • Consider undefined locations in memory to be reserved.	
w1c	Write 1 to clear: Refers to a register bitfield that must be written as 1 to be "cleared."	

Chapter 2 Introduction

2.1 Overview

Information found here provides an overview of this MCU, which is a part of Kinetis Eseries of ARM® Cortex®-M0+ MCUs and product family. It also presents high-level descriptions of the modules available on the device covered by this document.

2.2 Block Diagram

The following figure shows a top-level block diagram of the MCU superset device.

Figure 2-1. MCU block diagram

2.3 Module Functional Categories

The modules on this device are grouped into functional categories. The following sections describe the modules assigned to each category in more detail.

SRTC

PWT

Table 2-1. Module functional categories

Module category	Description
ARM [®] Cortex [®] -M0+ core and related modules	32-bit MCU core from ARM's Cortex-M class, 1.77 CoreMark®/MHz from single-cycle access memories, 72 MHz CPU frequency Debug interfaces
System modules	System integration module (SIM) System mode controller (SMC) Miscellaneous control module (MCM) Crossbar switch (AXBS-Lite) Bit manipulation engine (BME) Peripheral bridge (AIPS-Lite) Direct memory access (DMA) controller with multiplexer (DMAMUX) to increase available DMA requests. DMA can now handle transfers in VLPS mode Watchdog (WDOG) External watchdog monitor (EWM)
Memories and memory interfaces	Internal memories include: Program flash memory FlexMemory FlexNVM FlexRAM SRAM Boot ROM
Clocks	System clock generator (SCG) Low-Power-Frequency-locked loop (LPFLL) Fast internal reference clock (FIRC) Slow internal reference clock (SIRC) System oscillator (OSC) Low Power Oscillator (LPO) Peripheral Clock Control (PCC)
Security and integrity modules	 Cyclic Redundancy Check (CRC) module for error detection Flash Access Control (FAC) 128-bit unique identification (ID) number ADC self-test and calibration feature
Analog modules	High speed analog-to-digital converter (ADC) Comparator (CMP) Bandgap voltage reference (1V reference voltage) Power management controllers (PMC) Multiple power modes available based on run, wait, stop, and powerdown modes
Timer modules	 Programmable delay block (PDB) FlexTimers (FTM) Low-power periodic interrupt timer (LPIT) Low power timer (LPTMR) Independent real time clock (RTC)
Communication interfaces	 Low-power Serial peripheral interface (LPSPI) Low-power Inter-integrated circuit (LPI²C) Low-power UART (LPUART) FlexIO
Human-machine interfaces (HMI)	General purpose input/output controller (GPIO) Capacitive touch sense input (TSI) interface enabled in hardware

Module Functional Categories

Table 2-1. Module functional categories

Module category	Description
	 High drive I/O pins, see Pin properties. Digital filters, see "Ports summary" table in Port control and interrupt module features.

Chapter 3 Core Overview

3.1 ARM Cortex-M0+

The ARM Cortex-M0+ is the member of the Cortex-M Series of processors targeting the micro-controller market. It is an entry-level 32-bit processor designed for very cost sensitive, low power applications. The Cortex-M0+ has a 2-stage pipeline von Neumann architecture. The processor delivers exceptional energy efficiency through extensively optimized design and provides high-end processing hardware including a single-cycle multiplier. It also has an I/O port which supports single cycle loads and stores to tightly-coupled peripherals (e.g. GPIO).

The Cortex-M0+ processor implements the ARMv6-M architecture, which is upward compatible with other Cortex-M profile processors. It is based on the 16-bit Thumb® instruction set and includes Thumb-2 technology (including all but three 16-bit Thumb opcodes plus seven 32-bit instructions). The Cortex-M0+ instruction set provides the exceptional performance expected of a modern 32-bit architecture, with a higher code density than 8-bit and 16-bit microcontrollers.

Cortex-M0+ Processor Features

- Thumb instruction set with Thumb-2 technology
- Nested Vectored Interrupt Controller (NVIC)
- Single-cycle 32-bit hardware multiplier
- Single-cycle I/O port
- Serial-Wire Debug port (SWD)
- Breakpoint & Watchpoint Units
- Micro Trace Buffer (MTB)
- 24-bit system tick timer (SysTick)

The detailed architecture and programming model of Cortex-M0+ processor are discussed in the following documents from ARM.

Cortex-M0+ Devices Generic User Guide

Core Buses and Interfaces

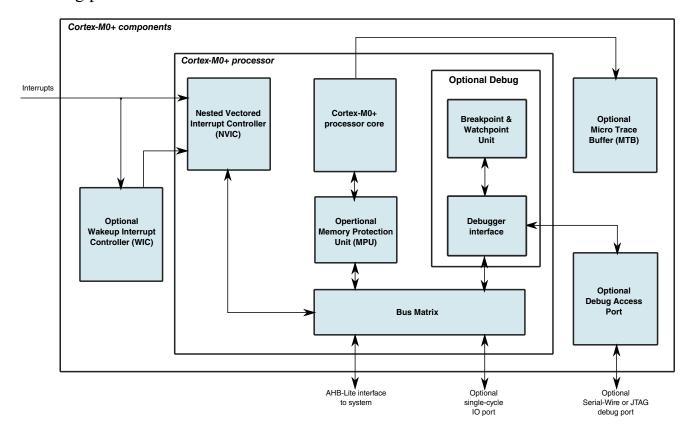
- Cortex-M0+ Technical Reference Manual
- ARMv6-M Architecture Reference Manual

3.2 Core Buses and Interfaces

The Cortex-M0+ processor provides a single system-level interface using AMBA[®] technology to provide memory and peripheral accesses, a single-cycle I/O port for high speed access to tightly-coupled peripherals (such as GPIO), a NVIC interface for interrupt handling, a Debug Access Port (DAP) for SWD debug and a Micro Trace Buffer (MTB) interface for trace.

The following interfaces are implemented on the Cortex-M0+ processor of this device.

- A single AHB-Lite bus
- A single-cycle IO port
- PPB bus
- NVIC interface
- MTB interface
- Debug port interface



55

3.3 Core Component Configuration

The processor supports optional tightly-coupled system components. The following table lists the specific configuration of the Cortex-M0+ core on this device.

Component name	Present on this device	Note
Single-cycle Multiplier	YES	
Single-cycle IO Port	YES	
SysTick	YES	
Halting debug	YES	
Watchpoint	YES	Include 2 comparators
Breakpoint	YES	Include 2 comparators
МТВ	YES	
WIC	YES	
Vector Table Offset Support	YES	
Unprivileged/Privileged Support	YES	
SWD	YES	
MPU	Not present	

3.4 SysTick Clock Configuration

The System Tick Timer's clock source is always the core clock (CORE_CLK) on this device. This results in the following:

- The CLKSOURCE bit in SysTick Control and Status Register (SYST_CSR) is always set to select the core clock.
- Because the timing reference (CORE_CLK) is a variable frequency, the TENMS bit in the SysTick Calibration Value Register (SYST_CALIB) is always zero.
- The NOREF bit in SysTick Calibration Value Register (SYST_CALIB) is always set, implying that CORE_CLK is the only available source of reference timing.

SysTick Clock Configuration

Chapter 4 Interrupts

4.1 Introduction

The ARM Cortex-M0+ processor includes an interrupt controller called the Nested Vectored Interrupt Controller (NVIC). It is closely coupled to the processor core to provide outstanding interrupt handling abilities and low latency interrupt processing. The NVIC supports nested interrupt, dynamic priority changes, interrupt masking and interrupt tail-chaining. In addition, the NVIC also supports re-locatable vector table and an external Nonmaskable Interrupt (NMI).

The NVIC registers are located within the processor's internal System Control Space (SCS) with base address of 0xE000E000. Most of the NVIC registers are accessible only in privileged mode. The detailed NVIC functionalities and registers descriptions are discussed in the following documents from ARM web.

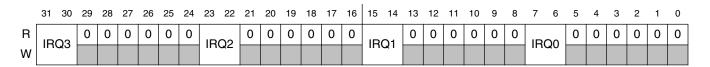
- Cortex-M0+ Devices Generic User Guide
- Cortex-M0+ Technical Reference Manual

4.2 NVIC configuration

The NVIC supports configurable interrupt number and level of priority. The following sections speficy the exact priority level and interrupt vectors implemented on this device.

Interrupt priority levels 4.2.1

The NVIC on this device supports 4 interrupt priority levels. Therefore, the NVIC_IPR registers contains 2 bits for each interrupt request (IRQ). For example, NVIC_IPR0 is shown below:



4.2.2 Non-maskable interrupt

This device supports non-maskable interrupt (NMI) to the NVIC. It is controlled by the external NMI signal from the pin. The pin which the NMI signal is multiplexed on, must be configured for the NMI function to generate the non-maskable interrupt request.

Interrupt channel assignments 4.3

The interrupt source assignments are defined in the following table.

- Vector number the value stored on the stack when an interrupt is serviced.
- IRQ number non-core interrupt source count, which is the vector number minus 16.

The IRQ number is used within ARM's NVIC documentation.

Table 4-2. Interrupt vector assignments

Address	Vector	IRQ ¹	NVIC IPR register number ²	Source module	Source description
ARM Core System H	andler Vec	tors			
0x0000_0000	0	_	_	ARM core	Initial Stack Pointer
0x0000_0004	1	_	_	ARM core	Initial Program Counter
0x0000_0008	2	_	_	ARM core	Non-maskable Interrupt (NMI)
0x0000_000C	3	_	_	ARM core	Hard Fault
0x0000_0010	4	_	_	_	_
0x0000_0014	5	_	_	_	_
0x0000_0018	6	_	_	_	_
0x0000_001C	7	_	_	_	_

Table continues on the next page...

58

Table 4-2. Interrupt vector assignments (continued)

Address	Vector	IRQ ¹	NVIC IPR register number ²	Source module	Source description
0x0000_0020	8	_	_	_	-
0x0000_0024	9	_	_	_	_
0x0000_0028	10	_	_	_	_
0x0000_002C	11	_	_	ARM core	Supervisor call (SVCall)
0x0000_0030	12	_	_	_	_
0x0000_0034	13	_	_	_	_
0x0000_0038	14	_	_	ARM core	Pendable request for system service (PendableSrvReq)
0x0000_003C	15	_	_	ARM core	System tick timer (SysTick)
Non-Core Vectors	•				
0x0000_0040	16	0	0	DMA	DMA channel 0 or 4 transfer complete
0x0000_0044	17	1	0	DMA	DMA channel 1 or 5 transfer complete
0x0000_0048	18	2	0	DMA	DMA channel 2 or 6 transfer complete
0x0000_004C	19	3	0	DMA	DMA channel 3 or 7 transfer complete
0x0000_0050	20	4	1	DMA	DMA error interrupt channels 0-7
0x0000_0054	21	5	1	Flash memory	Single interrupt vector for all sources
0x0000_0058	22	6	1	PMC	Low-voltage detect, low-voltage warning
0x0000_005C	23	7	1	Port control module	Pin detect (Port A, E)
0x0000_0060	24	8	2	LPI ² C0	Single interrupt vector for all sources
0x0000_0064	25	9	2	LPI ² C1	_
0x0000_0068	26	10	2	LPSPI0	Single interrupt vector for all sources
0x0000_006C	27	11	2	LPSPI1	Single interrupt vector for all sources
0x0000_0070	28	12	3	LPUART0	Single interrupt vector for all sources
0x0000_0074	29	13	3	LPUART1	Single interrupt vector for all sources
0x0000_0078	30	14	3	LPUART2	Single interrupt vector for all sources
0x0000_007C	31	15	3	ADC0	_
0x0000_0080	32	16	4	CMP0	_
0x0000_0084	33	17	4	FTM0	Single interrupt vector for all sources
0x0000_0088	34	18	4	FTM1	Single interrupt vector for all sources
0x0000_008C	35	19	4	FTM2	Single interrupt vector for all sources
0x0000_0090	36	20	5	RTC	Single interrupt vector for all sources
0x0000_0094	37	21	5	CMP1	-
0x0000_0098	38	22	5	LPIT	LPIT channel 0-3
0x0000_009C	39	23	5	FlexIO	_
0x0000_00A0	40	24	6	TSI	_
0x0000_00A4	41	25	6	PDB0	_
0x0000_00A8	42	26	6	Port control module	Pin detect (Port B, C, D)

Table continues on the next page...

Interrupt channel assignments

Table 4-2. Interrupt vector assignments (continued)

Address	Vector	IRQ ¹	NVIC IPR register number ²	Source module	Source description
0x0000_00AC	43	27	6	SCG	_
0x0000_00B0	44	28	7	WDOG or EWM	Both watchdog modules share this interrupt.
0x0000_00B4	45	29	7	PWT or LPTMR	Single interrupt vector for all sources
0x0000_00B8	46	30	7	ADC1	Single interrupt vector for all sources
0x0000_00BC	47	31	7	RCM	Single interrupt vector for all sources

- 1. Indicates the NVIC's interrupt source number.
- 2. Indicates the NVIC's IPR register number used for this IRQ. The equation to calculate this value is: IRQ div 4

4.3.1 Determining the bitfield and register location for configuring a particular interrupt

Suppose you need to configure the low-power timer (LPTMR) interrupt. The following table is an excerpt of the LPTMR row from Interrupt channel assignments (value number as example only).

Table 4-3. LPTMR interrupt vector assignment (example only)

Address	Vector	IRQ ¹	NVIC non-IPR register number ²	NVIC IPR register number ³	Source module	Source description
0x0000_0128	74	58	1	14	Low Power Timer	_

- 1. Indicates the NVIC's interrupt source number.
- 2. Indicates the NVIC's ISER, ICER, ISPR, ICPR, and IABR register number used for this IRQ. The equation to calculate this value is: IRQ div 32
- 3. Indicates the NVIC's IPR register number used for this IRQ. The equation to calculate this value is: IRQ div 4
 - The NVIC registers you would use to configure the interrupt are:
 - NVIC ISER1
 - NVIC ICER1
 - NVIC ISPR1
 - NVIC ICPR1
 - NVIC IABR1
 - NVIC IPR14
 - To determine the particular IRQ's bitfield location within these particular registers:
 - NVIC_ISER1, NVIC_ICER1, NVIC_ISPR1, NVIC_ICPR1, NVIC_IABR1 bit location = IRQ mod 32 = 26
 - NVIC_IPR14 bitfield starting location = $8 \times (IRQ \mod 4) + 4 = 20$

Since the NVIC_IPR bitfields are 2-bit wide (4 priority levels), the NVIC_IPR14 bitfield range is 20-21

Therefore, the following bitfield locations are used to configure the LPTMR interrupts:

- NVIC_ISER1[26]
- NVIC_ICER1[26]
- NVIC_ISPR1[26]
- NVIC_ICPR1[26]
- NVIC_IABR1[26]
- NVIC_IPR14[21:20]

Interrupt channel assignments

Chapter 5 System Integration Module (SIM)

5.1 Introduction

The System Integration Module (SIM) provides system control and chip configuration registers.

5.1.1 Features

Features of the SIM include:

- System clocking configuration
- Flash and system RAM size configuration
- FlexTimer clock and channel selection and configuration
- ADC trigger selection
- Flash configuration
- System device unique identification (UID)
- LPUART pseudo open drain control

5.2 Memory map and register definition

NOTE

The SIM registers can only be written in the supervisor mode. In the user mode, write accesses are blocked and will result in a bus error.

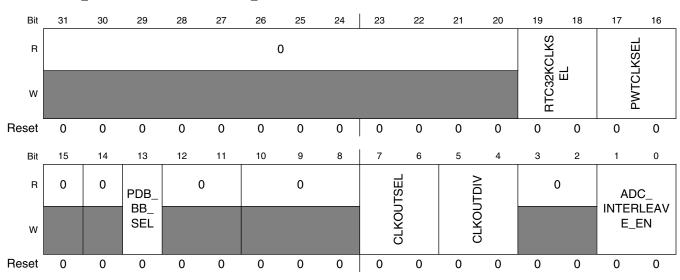
SIM memory map

Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page
4004_8004	Chip Control register (SIM_CHIPCTL)	32	R/W	0000_0000h	5.2.1/64
4004_800C	FTM Option Register 0 (SIM_FTMOPT0)	32	R/W	0000_0000h	5.2.2/66
4004_8018	ADC Options Register (SIM_ADCOPT)	32	R/W	0000_0000h	5.2.3/67
4004_801C	FTM Option Register 1 (SIM_FTMOPT1)	32	R/W	0000_0000h	5.2.4/69
4004_8024	System Device Identification Register (SIM_SDID)	32	R	See section	5.2.5/71
4004_804C	Flash Configuration Register 1 (SIM_FCFG1)	32	R	See section	5.2.6/72
4004_8050	Flash Configuration Register 2 (SIM_FCFG2)	32	R	See section	5.2.7/74
4004_8054	Unique Identification Register High (SIM_UIDH)	32	R	See section	5.2.8/75
4004_8058	Unique Identification Register Mid-High (SIM_UIDMH)	32	R	See section	5.2.9/75
4004_805C	Unique Identification Register Mid Low (SIM_UIDML)	32	R	See section	5.2.10/76
4004_8060	Unique Identification Register Low (SIM_UIDL)	32	R	See section	5.2.11/76
4004_806C	Miscellaneous Control register (SIM_MISCTRL)	32	R/W	0000_0000h	5.2.12/77

5.2.1 Chip Control register (SIM_CHIPCTL)

SIM_CHIPCTL contains the controls for selecting PWT alternative clock source, ADC COCO trigger, trace clock, clock out source, PDB back-to-back mode and ADC interleave channel.

Address: 4004_8000h base + 4h offset = 4004_8004h



SIM_CHIPCTL field descriptions

Field	Description
31–20	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

SIM_CHIPCTL field descriptions (continued)

Field	Description
19–18	RTC 32K clock input select
RTC32KCLKSEL	00 OSC32 clock output
	01 RTC_CLKIN
	10 Reserved
	11 Reserved
17–16 PWTCLKSEL	PWT clock source select
	00 PWT alternative clock is from the TCLK0 pin.
	01 PWT alternative clock is from the TCLK1 pin.
	10 PWT alternative clock is from the TCLK2 pin. 11 Reserved
15	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
14 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
13 PDB_BB_SEL	PDB back-to-back select
	Selects ADC COCO source as pdb back-to-back mode, see Back-to-back acknowledge connectivity in PDB Inter-connectivity Information for details.
	PDB0 channel 0 back-to-back operation with ADC0 COC0[1:0] and PDB0 channel 1 back-to-back operation with ADC1 COC0[1:0]
	1 PDB0 Channel 0 back-to-back operation with COCO[0] of ADC0 and COCO[1] of ADC1; PDB0 Channel 1 back-to-back operation with COCO[0] of ADC1 and COCO[1] of ADC0
12–11	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
10–8 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
7–6	CLKOUT Select
CLKOUTSEL	Selects the clock to output on the CLKOUT pin.
	00 Reseved
	01 SCGCLKOUT(SIRC/FIRC/SOSC/LPFLL), see SCG_CLKOUTCNFG register.
	10 RTC oscillator (OSC32) clock (32 kHz)
	11 LPO clock (128 kHz)
5–4 CLKOUTDIV	CLKOUT divider ratio
	00 Divided by 1
	01 Divided by 2
	10 Divided by 411 Divided by 8
3–2	This field is reserved.
3–2 Reserved	This read-only field is reserved and always has the value 0.
ADC_	ADC interleave channel enable
INTERLEAVE_ EN	Select ADC interleave pins. Bit 1 to 0 are for PTB1 and PTB0 respectively.

Table continues on the next page...

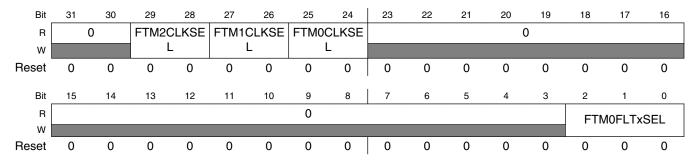
Memory map and register definition

SIM_CHIPCTL field descriptions (continued)

Field	Description			
	00 No interleave channel			
	Bit 1: PTB1 to ADC0_SE5 and ADC1_SE15			
	Bit 0: PTB0 to ADC0_SE4 and ADC1_SE14			

5.2.2 FTM Option Register 0 (SIM_FTMOPT0)

Address: 4004_8000h base + Ch offset = 4004_800Ch



SIM_FTMOPT0 field descriptions

Field	Description				
31–30	This field is reserved.				
Reserved	This read-only field is reserved and always has the value 0.				
29–28 FTM2CLKSEL	FTM2 External Clock Pin Select				
	Selects the external pin used to drive the clock to the FTM2 module.				
	NOTE: The selected pin must also be configured for the FTM external clock function through the appropriate Pin Control Register in the Port Control module.				
	00 FTM2 external clock driven by TCLK0 pin.				
	01 FTM2 external clock driven by TCLK1 pin.				
	10 FTM2 external clock driven by TCLK2 pin.				
	11 No clock input				
27–26	FTM1 External Clock Pin Select				
FTM1CLKSEL	Selects the external pin used to drive the clock to the FTM1 module.				
	NOTE: The selected pin must also be configured for the FTM external clock function through the appropriate Pin Control Register in the Port Control module.				
	00 FTM1 external clock driven by TCLK0 pin.				
	01 FTM1 external clock driven by TCLK1 pin.				
	10 FTM1 external clock driven by TCLK2 pin.				
	11 No clock input				
25–24	FTM0 External Clock Pin Select				
FTM0CLKSEL	Selects the external pin used to drive the clock to the FTM0 module.				

Table continues on the next page...

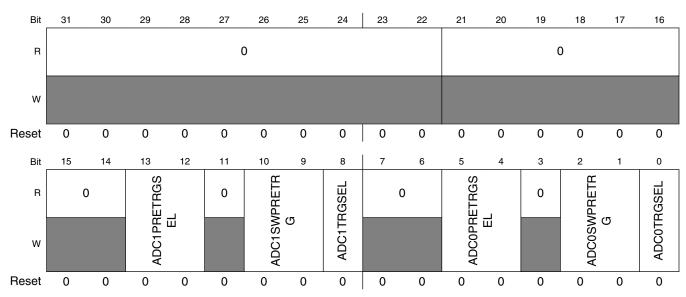
67

SIM_FTMOPT0 field descriptions (continued)

Field	Description			
	NOTE: The selected pin must also be configured for the FTM external clock function through the appropriate Pin Control Register in the Port Control module.			
	00 FTM0 external clock driven by TCLK0 pin.			
	01 FTM0 external clock driven by TCLK1 pin.			
	10 FTM0 external clock driven by TCLK2 pin.			
	11 No clock input			
23–3	This field is reserved.			
Reserved	This read-only field is reserved and always has the value 0.			
FTM0FLTxSEL	FTM0 Fault x Select			
	Selects the source of FTM0 fault. Every bit means one fault input respectively.			
	NOTE: The pin source for fault must be configured for the FTM module fault function through the appropriate pin control register in the port control module when it comes from external fault pin. TRGMUX_FTM0 SELx is corresponding to FTM0 Fault x input.			
	Bit value = 0: FTM0_FLTx pin			
	Bit value = 1: TRGMUX_FTM0 out			

5.2.3 ADC Options Register (SIM_ADCOPT)

Address: 4004_8000h base + 18h offset = 4004_8018h



SIM_ADCOPT field descriptions

Field	Description
31–22	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Memory map and register definition

SIM_ADCOPT field descriptions (continued)

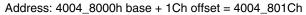
Field	Description											
21–16	This field is reserved.											
Reserved	This read-only field is reserved and always has the value 0.											
15–14	This field is reserved.											
Reserved	This read-only field is reserved and always has the value 0.											
13–12 ADC1PRETRGSEL	ADC1 pre-trigger source select											
7.20111.21116.622	Selects pre-trigger source for ADC1.											
	00 PDB output											
	01 TRGMUX output											
	10 ADC1 software pre-trigger											
	11 Reserved											
11 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.											
10–9	ADC1 software pre-trigger sources											
ADC1SWPRETRG	ADOT Software pre-trigger sources											
	00 disabled											
	01 software pre-trigger 0											
	10 software pre-trigger 1 11 disabled											
8	ADC1 trigger source select											
ADC1TRGSEL												
	Selects trigger source for ADC1.											
	NOTE: Each PDB supports two ADC channels, and each channel is with 2 pre-triggers.											
	0 PDB output											
	1 TRGMUX output											
7–6	This field is reserved.											
Reserved	This read-only field is reserved and always has the value 0.											
5–4 ADC0PRETRGSEL	ADC0 pre-trigger source select											
ADOUTHLINGSEE	Selects pre-trigger source for ADC0.											
	00 PDB output											
	01 TRGMUX output											
	10 ADC0 software pre-trigger											
	11 Reserved											
3	This field is reserved.											
Reserved	This read-only field is reserved and always has the value 0.											
2–1 ADC0SWPRETRG	ADC0 software pre-trigger sources											
	00 disabled											
	01 software pre-trigger 0											
	10 software pre-trigger 1											
	11 disabled											
0 ADC0TRGSEL	ADC0 trigger source select											
/IDOUTHGOLL	Selects trigger source for ADC0.											

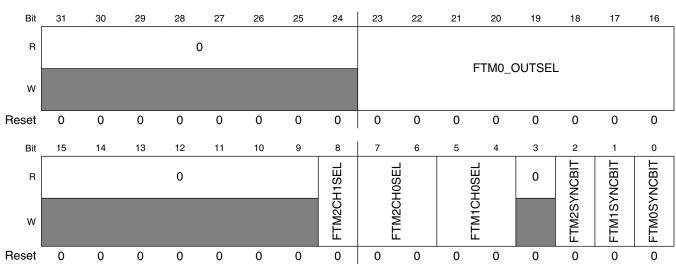
Table continues on the next page...

SIM_ADCOPT field descriptions (continued)

Field	Description										
	NOTE: Each PDB supports two ADC channels, and each channel is with 2 pre-triggers.										
	0 PDB output 1 TRGMUX output										

5.2.4 FTM Option Register 1 (SIM_FTMOPT1)





SIM_FTMOPT1 field descriptions

Field	Description								
31–24	This field is reserved.								
Reserved	This read-only field is reserved and always has the value 0.								
23-16 FTM0_OUTSEL	FTM0 channel modulation select with FTM1_CH1								
_	Bit 7 to 0 are for channel 7 to 0 respectively.								
	0 No modulation with FTM1_CH1								
	1 Modulation with FTM1_CH1								
15–9	This field is reserved.								
Reserved	This read-only field is reserved and always has the value 0.								
8	FTM2 CH1 Select								
FTM2CH1SEL	Selects FTM2 CH1 input								
	0 FTM2_CH1 input								
	1 exclusive OR of FTM2_CH0, FTM2_CH1, and FTM1_CH1								
7–6 FTM2CH0SEL	FTM2 CH0 Select								
	Selects FTM2 CH0 input								

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Memory map and register definition

SIM_FTMOPT1 field descriptions (continued)

Field	Description									
	00 FTM2_CH0 input									
	01 CMP0 output									
	10 CMP1 output									
	11 Reserved									
5–4 FTM1CH0SEL	FTM1 CH0 Select									
	Selects FTM1 CH0 input									
	00 FTM1_CH0 input									
	01 CMP0 output									
	10 CMP1 output									
	11 Reserved									
3	This field is reserved.									
Reserved	This read-only field is reserved and always has the value 0.									
2	FTM2 Sync Bit									
FTM2SYNCBIT	Software control for FTM2 hardware trigger synchronization									
	0 No effect.									
	1 Write 1 to assert the TRIG1 input to FTM2. Software must clear this bit to allow other trigger sources to assert.									
1	FTM1 Sync Bit									
FTM1SYNCBIT	Software control for FTM1 hardware trigger synchronization									
	0 No effect.									
	1 Write 1 to assert the TRIG1 input to FTM1. Software must clear this bit to allow other trigger sources to assert.									
0 FTM0SYNCBIT	FTM0 Sync Bit									
	Software control for FTM0 hardware trigger synchronization									
	0 No effect.									
	1 Write 1 to assert the TRIG1 input to FTM0. Software must clear this bit to allow other trigger sources to assert.									

71

5.2.5 System Device Identification Register (SIM_SDID)

NOTE

Reset value loaded during System Reset from Flash IFR.

Address: 4004_8000h base + 24h offset = 4004_8024h

Bit	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
R	F	AM	ILYI	D	S	UBF	AM	ID	S	ERI	ESI	D	R	AM	SIZI	E		RE	۷ID		ı	PRO	JEC	CTIE)			Ρ	INI)		
W																																
Reset	х*	х*	х*	х*	x*	х*	х*	х*	х*	х*	х*	х*	X*	х*	х*	х*	х*	х*	х*	х*	0	0	0	1	0	x*	х*	х*	х*	х*	х*	x*

^{*} Notes:

SIM_SDID field descriptions

Field	Description
31–28 FAMILYID	Kinetis E-series Family ID
	Specifies the Kinetis E-series family of the device.
	0001 KE1x Family (Enhanced features)
27–24 SUBFAMID	Kinetis E-series Sub-Family ID
00217111112	Specifies the Kinetis E-series sub-family of the device.
23–20 SERIESID	Kinetis Series ID
OEI IIIEOID	Specifies the Kinetis series of the device.
	0010 Kinetis E+ series
19–16 RAMSIZE	RAM size
TUMMOIZE	This field specifies the amount of system RAM available on the device.
	0101 16 KB
	0110 32 KB
	Others Reserved
15–12 REVID	Device revision number
	Specifies the silicon implementation number for the device.
11–7	Project ID
PROJECTID	Specifies the silicon feature set identication number for the device.
	00010 for this device.
PINID	Pin identification
	Specifies the pin count of the device.

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

[•] x = Undefined at reset.

SIM_SDID field descriptions (continued)

Field	Description
	0000111 64-pin
	0001010 100-pin

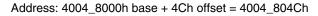
Flash Configuration Register 1 (SIM_FCFG1) 5.2.6

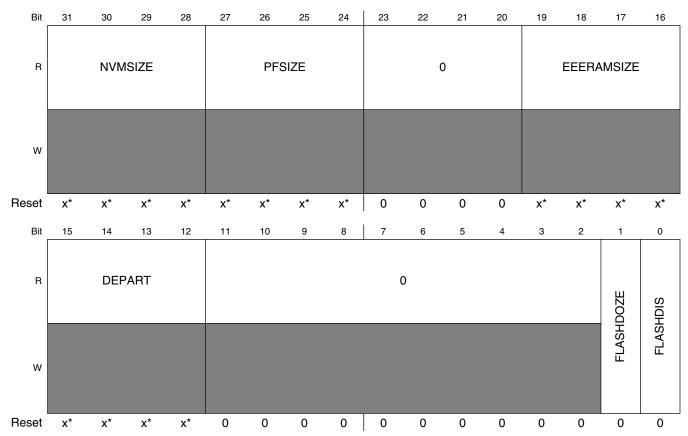
NOTE

Reset values of NVMSIZE, PFSIZE, EEERAM_SIZE, DEPART are loaded during System Reset from Flash IFR.

NOTE

Reset values of EESIZE and DEPART are based on user programming in user IFR via the PGMPART flash command.





^{*} Notes:

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018 72 **NXP Semiconductors**

[•] x = Undefined at reset.

SIM_FCFG1 field descriptions

Field	Description		
31–28 NVMC17E	FlexNVM size		
NVMSIZE	This field specifies the amount of FlexNVM memory available on the device. Undefined values are reserved.		
	0000 0 KB of FlexNVM		
	0011 32 KB of FlexNVM		
27–24 PFSIZE	Program flash size This field specifies the amount of program flash memory available on the device . Undefined values are		
	reserved.		
	0111 128 KB of program flash memory, 4 KB protection region		
	1001 256 KB of program flash memory, 8 KB protection region		
23–20 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.		
19–16 EEERAMSIZE	EEE SRAM SIZE		
	EEE SRAM data size .		
	0011 2 KB		
	0100 1 KB		
	0101 512 Bytes 0110 256 Bytes		
	0110 256 Bytes 0111 128 Bytes		
	1000 64 Bytes		
	1001 32 Bytes		
15–12	FlexNVM partition		
DEPART	Data flash / EEPROM backup split . See DEPART bit description in FTFE chapter.		
11–2 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.		
1 FLASHDOZE	Flash Doze		
TEAGINGE	When set, Flash memory is disabled for the duration of Doze mode. An attempt by the DMA or other bus master to access the Flash when the Flash is disabled will result in a bus error. This bit should be clear during VLP modes. The Flash will be automatically enabled again at the end of Doze mode so interrupt vectors do not need to be relocated out of Flash memory. The wakeup time from Doze mode is extended when this bit is set.		
	0 Flash remains enabled during Doze mode		
	1 Flash is disabled for the duration of Doze mode		
0 FLASHDIS	Flash Disable		
	Flash accesses are disabled (and generate a bus error) and the Flash memory is placed in a low power state. This bit should not be changed during VLP modes. Relocate the interrupt vectors out of Flash memory before disabling the Flash.		
	0 Flash is enabled		
	1 Flash is disabled		

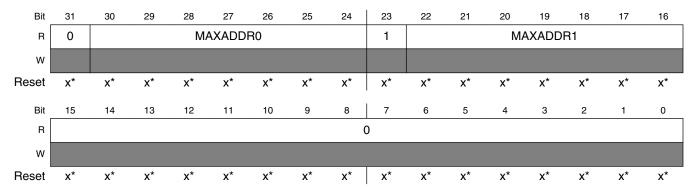
Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

5.2.7 Flash Configuration Register 2 (SIM_FCFG2)

NOTE

Reset values of MAXADDR0 and MAXADDR1 are loaded during System Reset from Flash IFR.

Address: 4004_8000h base + 50h offset = 4004_8050h



^{*} Notes:

SIM_FCFG2 field descriptions

Field	Description	
31 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.	
30–24 MAXADDR0	Max address block 0 This field concatenated with 13 trailing zeros indicates the first invalid address of program flash (block 0). For example, if MAXADDR0 = 0x10, the first invalid address of program flash (block 0) is 0x0002_0000. This would be the MAXADDR0 value for a device with 128 KB program flash in flash block 0.	
23 Reserved	This field is reserved. This read-only field is reserved and always has the value 1.	
22–16 MAXADDR1	Max address block 1 This field concatenated with 13 trailing zeros indicates the first invalid address of data flash (block 1).	
Reserved	This field is reserved. This read-only field is reserved and always has the value 0.	

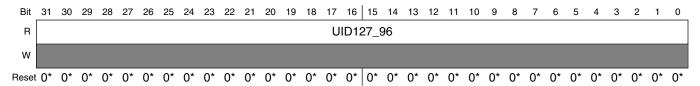
Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018 74 **NXP Semiconductors**

[•] Reset value loaded during System Reset from Flash IFR.x = Undefined at reset.

75

5.2.8 Unique Identification Register High (SIM_UIDH)

Address: 4004_8000h base + 54h offset = 4004_8054h



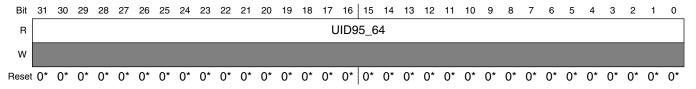
- * Notes:
- Reset value loaded during System Reset from Flash IFR.

SIM_UIDH field descriptions

Field	Description
UID127_96	Unique Identification
	Unique identification for the device.

5.2.9 Unique Identification Register Mid-High (SIM_UIDMH)

Address: 4004_8000h base + 58h offset = 4004_8058h



- * Notes
- Reset value loaded during System Reset from Flash IFR.

SIM_UIDMH field descriptions

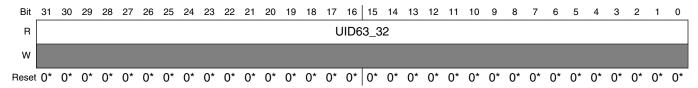
Field	Description
UID95_64	Unique Identification
	Unique identification for the device.

NXP Semiconductors

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

5.2.10 Unique Identification Register Mid Low (SIM_UIDML)

Address: 4004_8000h base + 5Ch offset = 4004_805Ch



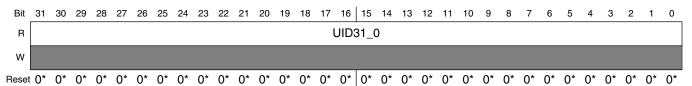
- * Notes:
- Reset value loaded during System Reset from Flash IFR.

SIM_UIDML field descriptions

Field	Description	
UID63_32	Unique Identification	
	Unique identification for the device.	

5.2.11 Unique Identification Register Low (SIM_UIDL)

Address: 4004_8000h base + 60h offset = 4004_8060h

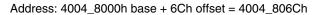


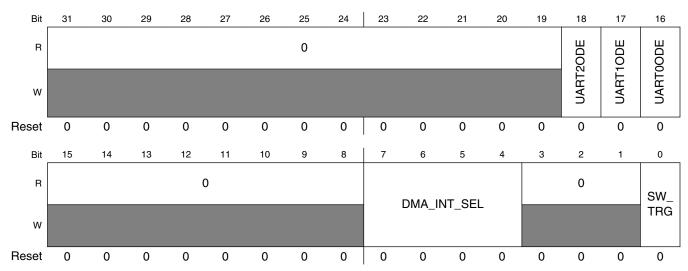
- * Notes
- · Reset value loaded during System Reset from Flash IFR.

SIM_UIDL field descriptions

Field	Description	
UID31_0	Unique Identification	
	Unique identification for the device.	

5.2.12 Miscellaneous Control register (SIM_MISCTRL)





SIM_MISCTRL field descriptions

Field	Description				
31–19	This field is reserved.				
Reserved	This read-only field is reserved and always has the value 0.				
18 UART2ODE	UART2 Open Drain Enable				
	0 Open drain is disabled on UART2				
	1 Open drain is enabled on UART2				
17 UART1ODE	UART1 Open Drain Enable				
	0 Open drain is disabled on UART1				
	1 Open drain is enabled on UART1				
16 UART0ODE	UART0 Open Drain Enable				
	0 Open drain is disabled on UART0				
	1 Open drain is enabled on UART0				
15–8	This field is reserved.				
Reserved	This read-only field is reserved and always has the value 0.				
7–4 DMA_INT_SEL	DMA channel interrupt OR select				
DIVIA_INT_SEL	Bit 7 of DMA channel 7 and channel 3 interrupt select bit (logic 1 is ch7 and logic 0 is ch3) SIM_MISCTRL				
	Bit 6 of DMA channel 6 and channel 2 interrupt select bit (logic 1 is ch6 and logic 0 is ch2) SIM_MISCTRL				
	Bit 5 of DMA channel 5 and channel 1 interrupt select bit (logic 1 is ch5 and logic 0 is ch1) SIM_MISCTRL				
	Bit 4 of DMA channel 4 and channel 0 interrupt select bit (logic 1 is ch4 and logic 0 is ch0) SIM_MISCTRL				

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Memory map and register definition

SIM_MISCTRL field descriptions (continued)

Field	Description
3–1 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
0 SW_TRG	Software Trigger bit to TRGMUX

Chapter 6 Memory-Mapped Divide and Square Root (MMDVSQ)

6.1 Chip-specific Information for this Module

In this block chapter, PBRIDGE stands for the Peripheral Bridge, with the same meaning as AIPS-Lite.

6.2 Introduction

ARM processor cores in the Cortex-M family implementing the ARMv6-M instruction set architecture do not include hardware support for integer divide operations. The affected processors include the Cortex-M0+ core. However, in certain deeply embedded application spaces, hardware support for this class of arithmetic operation (along with an unsigned square root function) is important to maximize system performance and minimize device power dissipation. Accordingly, the MMDVSQ module is included in select microcontrollers, to serve as a memory-mapped co-processor located in a special address space (within the system memory map) that is accessible only to the processor core.

The MMDVSQ module supports execution of the integer divide operations defined in the ARMv7-M instruction set architecture, plus an unsigned integer square root operation. The supported integer divide operations include 32/32 signed (SDIV) and unsigned (UDIV) calculations.

6.2.1 Features

The key features of the MMDVSQ include:

• Lightweight implementation of 32-bit integer divide and square root arithmetic operations

Introduction

- Supports 32/32 signed and unsigned divide (or remainder) calculations
- Supports 32-bit unsigned square root calculations
- Simple programming model includes input data and result registers plus a control/ status register
- Programming model interface optimized for activation from inline code or software library call
 - "Fast Start" configuration minimizes the memory-mapped register write overhead
 - Supports two methods to determine when result is valid, including software polling
 - Configurable divide-by-zero response
- Pipelined design processes 2 bits per cycle with early termination exit for minimum execution time

6.2.2 Block diagram

A generic block diagram of the processor core and platform for this class of ultra low-end microcontrollers is shown in Figure 6-1. The MMDVSQ module's location as a memory-mapped co-processor is highlighted.

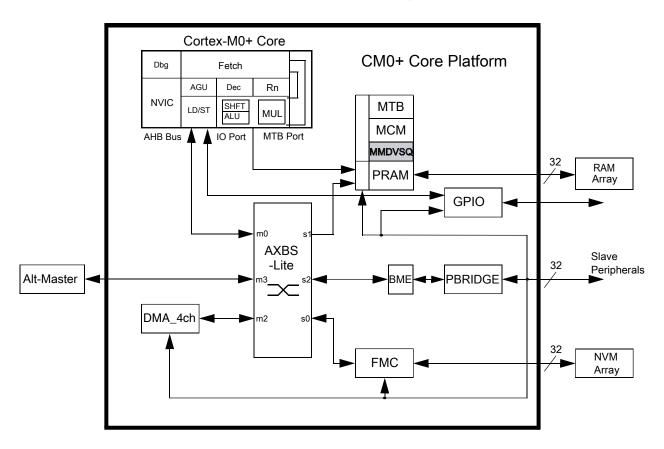


Figure 6-1. Generic Cortex-M0+ Core Platform Block Diagram

Next, a block diagram of the internal structure of the MMDVSQ module is presented. See Figure 6-2.

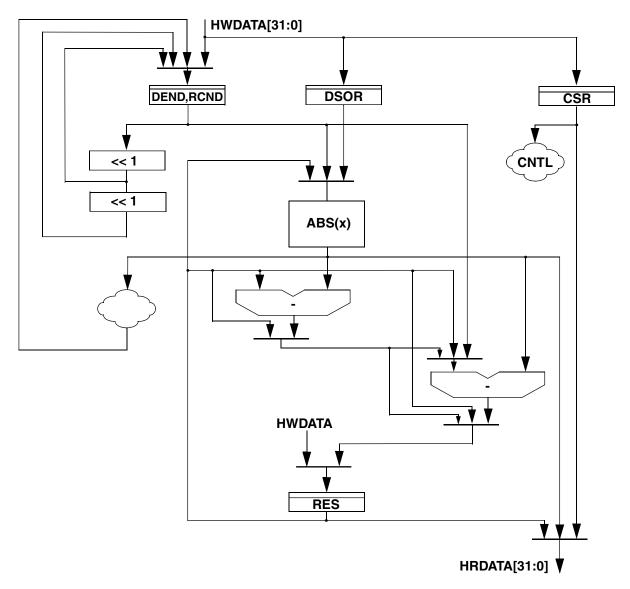


Figure 6-2. MMDVSQ Block Diagram

6.2.3 Modes of operation

The MMDVSQ module does not support any special modes of operation. As a memory-mapped device located on a crossbar slave AHB system bus port, MMDVSQ responds based strictly on memory addresses to its programming model.

All functionality associated with the MMDVSQ module resides in the core platform's clock domain; this includes its connections with the crossbar slave port. To minimize power dissipation, the design supports an architectural clock gate for the entire module, that is, the MMDVSQ is only clocked when responding to bus requests to its programming model or is busy performing a calculation.

6.3 External signal description

The MMDVSQ module does not directly support any external interfaces.

The internal interface includes a standard 32-bit AHB bus as shown in Figure 6-1.

6.4 Memory map and register definition

The MMDVSQ module supports a small number of program-visible registers used for passing input operands and retrieving the output result plus a configuration/status register.

The programming model occupies the first 20 bytes of a standard 4 Kb address slot. It can only be accessed via word-sized (32 bit) accesses. Attempted accesses using smaller data sizes, reading the write-only location or to reserved space are terminated with an error.

At any instant in time, the MMDVSQ can perform either a divide or square root calculation. The basic integer operations supported by the MMDVSQ are:

For divide:

```
MMDVSQ_RES = quotient (MMDVSQ_DEND / MMDVSQ_DSOR)
MMDVSQ RES = remainder (MMDVSQ DEND % MMDVSQ DSOR)
```

For square root:

```
MMDVSQ_RES = integer (\sqrt{MMDVSQ_RCND})
```

The register usage, based on the operation (divide, square root), is detailed in Table 6-1.

Table 6-1. Register Usage = f(Divide, Square Root)

Register	Divide	Square Root	Description
Dividend (MMDVSQ_DEND)	Yes	No	Input dividend (numerator) for the divide
Divisor (MMDVSQ_DSOR)	Yes	No	Input divisor (denominator) for the divide
Control/Status (MMDVSQ_CSR)	Yes	Yes	Control for divide, status for divide and square root
Result (MMDVSQ_RES)	Yes	Yes	Output result
Radicand (MMDVSQ_RCND)	No	Yes	Input "square" data

NXP Semiconductors

83

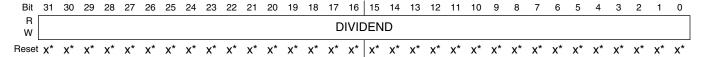
MMDVSQ memory map

Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page
F000_4000	Dividend Register (MMDVSQ_DEND)	32	R/W	Undefined	6.4.1/84
F000_4004	Divisor Register (MMDVSQ_DSOR)	32	R/W	Undefined	6.4.2/84
F000_4008	Control/Status Register (MMDVSQ_CSR)	32	R/W	See section	6.4.3/86
F000_400C	Result Register (MMDVSQ_RES)	32	R/W	Undefined	6.4.4/89
F000_4010	Radicand Register (MMDVSQ_RCND)	32	W	Undefined	6.4.5/89

6.4.1 Dividend Register (MMDVSQ_DEND)

This register is loaded with the input dividend operand before a divide operation is initiated. The register is updated by the MMDVSQ hardware during the execution of a divide or square root calculation. Any memory access (read or write) of the DEND register while the module is busy during a calculation causes the access to be stalled (using wait states) until the calculation completes.

Address: F000_4000h base + 0h offset = F000_4000h



^{*} Notes:

MMDVSQ_DEND field descriptions

Field	Description
DIVIDEND	Dividend
	This is the input dividend operand for divide calculations.

Divisor Register (MMDVSQ_DSOR) 6.4.2

This register is loaded with the input divisor operand before a divide operation is initiated. If CSR[DFS] = 0, a write to this register initiates a divide operation. Any memory access (read or write) of the DSOR register while the module is busy during a calculation causes the access to be stalled (using wait states) until the calculation completes.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018 84 NXP Semiconductors

x = Undefined at reset.

Chapter 6 Memory-Mapped Divide and Square Root (MMDVSQ)

If a divide operation is inititated with DSOR = 0, the hardware signals a divide-by-zero condition and sets RES = 0 and CSR[DZ] = 1. If CSR[DZE] = 1, an attempted read of the RES result is error terminated.

Address: F000_4000h base + 4h offset = F000_4004h



^{*} Notes:

MMDVSQ_DSOR field descriptions

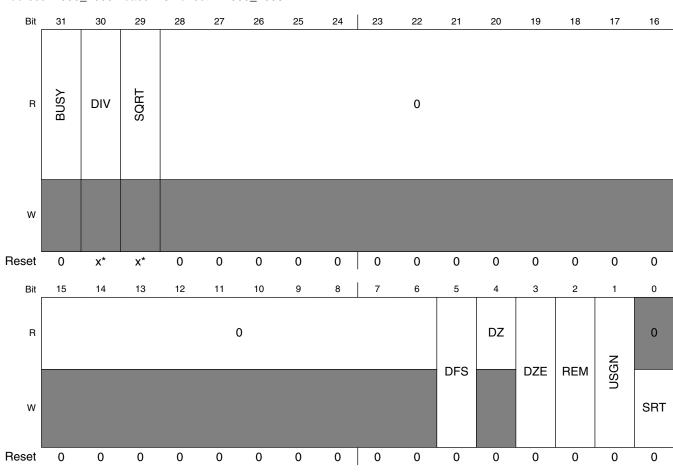
Field	Description
DIVISOR	Divisor
	This is the input divisor operand for divide calculations.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

[•] x = Undefined at reset.

6.4.3 Control/Status Register (MMDVSQ_CSR)

This register defines the operating configuration of divide operations and provides status information. The upper 3 bits provide busy status indicators, while the low-order byte defines the configuration for divide operations. The read-only status bits in CSR[31:29] are valid for both divide and square root operations; the configuration and status bit in CSR[5:0] are only valid for divides. A memory write access of the CSR register while the module is busy during a calculation causes the access to be stalled (using wait states) until the calculation completes.



Address: F000_4000h base + 8h offset = F000_4008h

MMDVSQ_CSR field descriptions

Field	Description
31 BUSY	BUSY This read-only bit is asserted when the MMDVSQ is performing a divide or square root. When an operation is initiated, the hardware sets this flag. It remains asserted until the operation completes and the

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

^{*} Notes:

[•] x = Undefined at reset.

MMDVSQ_CSR field descriptions (continued)

Field	Description
	hardware automatically clears the indicator. This bit can be used to poll the DVSQ's execution status. The combined CSR[BUSY, DIV, SQRT] indicators provide an encoded module status: • If 0b001, then MMDVSQ is idle and the last calculation was a square root • If 0b101, then MMDVSQ is idle and the last calculation was a divide • If 0b101, then MMDVSQ is busy processing a square root calculation • If 0b110, then MMDVSQ is busy processing a divide calculation
	The remaining encodings of CSR[BUSY, DIV, SQRT] are reserved.
	 MMDVSQ is idle MMDVSQ is busy performing a divide or square root calculation
30 DIV	DIVIDE
	Current or last operation was a divide. This read-only indicator bit signals if the current or last operation performed by the MMDVSQ was a divide.
	Current or last MMDVSQ operation was not a divide Current or last MMDVSQ operation was a divide
29 SQRT	SQUARE ROOT
	Current or last operation was a square root. This read-only indicator bit signals if the current or last operation performed by the MMDVSQ was a square root.
	Current or last MMDVSQ operation was not a square root Current or last MMDVSQ operation was a square root
28–6 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
5	Disable Fast Start
DFS	The MMDVSQ supports 2 mechanisms for initiating a divide operation. The default mechanism is a "fast start" where a write to the DSOR register begins the divide. Alternatively, the start mechanism can begin after a write to the CSR register with CSR[SRT] set. The CSR[DFS] indicator selects the divide start mechanism.
	0 A divide operation is initiated by a write to the DSOR register
	1 A divide operation is initiated by a write to the CSR register with CSR[SRT] = 1
4 DZ	Divide-by-Zero This read-only status indicator signals the last divide operation had a zero divisor, that is, DSOR = 0x0000_0000. For this case, RES is set to 0x0000_0000 and this indicator bit set. After a divide-by-zero operation, a read of the RES register returns either the zero result, or, if CSR[DZE] = 1, terminates the read with an error. The CSR[DZ] indicator is cleared by the hardware at the beginning of each operation.
	 The last divide operation had a non-zero divisor, that is, DSOR != 0 The last divide operation had a zero divisor, that is, DSOR = 0
3	Divide-by-Zero-Enable
DZE	This indicator configures the MMDVSQ's response to divide-by-zero calculations. If both CSR[DZ] and CSR[DZE] are set, then a subsequent read of the RES register is error terminated to signal the processor of the attempted divide-by-zero.

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Memory map and register definition

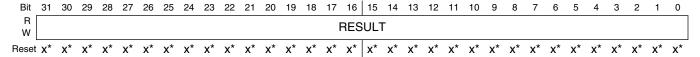
MMDVSQ_CSR field descriptions (continued)

Field	Description
	0 Reads of the RES register return the register contents
	1 If CSR[DZ] = 1, an attempted read of RES register is error terminated to signal a divide-by-zero, else the register contents are returned
2 REM	REMainder calculation
	This indicator selects whether the quotient or the remainder is returned in the RES register. The combined
	CSR[REM] and CSR[USGN] bits define four possible divide operations:
	 If CSR[REM, USGN] = 0b00, perform a signed divide, returning the quotient If CSR[REM, USGN] = 0b01, perform an unsigned divide, returning the quotient
	If CSR[REM, USGN] = 0b10, perform a signed divide, returning the remainder
	If CSR[REM, USGN] = 0b11, perform an unsigned divide, returning the remainder
	0 Return the quotient in the RES for the divide calculation
	1 Return the remainder in the RES for the divide calculation
1 USGN	Unsigned calculation
OGGIN	This indicator selects whether a signed (default) or unsigned divide is performed. See the CSR[REM] description for the encoding of the four possible divide operations.
	0 Perform a signed divide
	1 Perform an unsigned divide
0 SBT	Start
SRT	When written with a logical one and CSR[DFS] = 1, this flag initiates a divide operation. If written as a logical one with CSR[DFS] = 0, it is ignored. This bit always reads as a zero. The state of the register write data defines this bit's function.
	 No operation initiated If CSR[DFS] = 1, then initiate a divide calculation, else ignore

6.4.4 Result Register (MMDVSQ_RES)

This register is loaded with the result of the divide or square root calculation. It is updated by the MMDVSQ hardware at the completion of the calculation. When a square root operation is performed (on an unsigned 32-bit number), the result is limited to a 16-bit value with RES[31:16] = 0×0000 . Any memory access (read or write) of the RES register while the module is busy during a calculation causes the access to be stalled (using wait states) until the calculation completes and the new result written into the register.

Address: F000_4000h base + Ch offset = F000_400Ch



^{*} Notes:

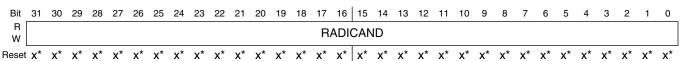
MMDVSQ_RES field descriptions

Field	Description
RESULT	Result
	This is the output result for a divide or square root calculation.

6.4.5 Radicand Register (MMDVSQ_RCND)

The write-only radicand register is loaded with the input "square" number. A memory write to the radicand register initiates a square root calculation. While the MMDVSQ module is busy performing a square root calculation, any memory write access to the RCND register causes the write access to be stalled (using wait states) until the square root calculation finishes. Any attempted read of the radicand register terminates with an error.

Address: F000_4000h base + 10h offset = F000_4010h



^{*} Notes:

NXP Semiconductors

89

[•] x = Undefined at reset.

x = Undefined at reset.

MMDVSQ_RCND field descriptions

Field	Description
RADICAND	Radicand
	This is the input radicand for a square root calculation, that is, the input "square" number.

6.5 Functional description

This section details the algorithms, execution times of the MMDVSQ, and the software interface to the module.

6.5.1 Algorithms

This section provides more details on the integer divide and square root algorithms.

6.5.1.1 Integer divide including special cases

6.5.1.1.1 Overview

The MMDVSQ module implements a "shift, test, and restore" radix-2 algorithm for unsigned integer divide operations. When performing a signed divide calculation, negative input operands are converted into 2's complement positive numbers first, an unsigned divide performed, and the sign of the results based on the input operand signs, namely:

- The sign of the remainder is the same as the sign of the dividend
- The quotient is negated if the signs of the dividend and divisor are different

The hardware implementation processes two bits per machine cycle and includes "early termination" logic where the execution time is data dependent, based on the magnitude of the positive dividend. See Table 6-4 for more execution time details.

6.5.1.1.2 Special case: Overflow

There is a single "special overflow case" affecting signed integer divides. If the dividend $= 0x8000_0000$ and the divisor $= 0xFFFF_FFF$, the result of this $(-2^{31}/-1)$ operation cannot be expressed as a 32-bit 2's complement number. For this case, the MMDVSQ exactly follows the ARM Cortex-Mx definition and returns $0x8000_0000$ (the lower 32 bits of the $+2^{31}$ result) as the quotient with no indication of the overflow condition. If the remainder is selected as the output of this calculation, it returns $0x0000_0000$.

Special case: Divide-by-Zero 6.5.1.1.3

For both signed and unsigned divides, if the divisor is zero, the MMDVSQ hardware detects this condition and the CSR[DZ] indicator set. The quotient result is forced to 0x0000 0000. If the remainder is selected as the output of this calculation, it also returns $0x0000_0000$. Additionally, if CSR[DZE] = 1, then an attempted read of the Result register (RES) is error terminated to provide a simple mechanism to signal software of the divide-by-zero condition.

6.5.1.2 Integer square root

6.5.1.2.1 Overview

The unsigned square root algorithm begins by creating a 32-bit "one-hot" bit vector signaling the highest power of four of the contents of the Radicand register (RCND). It then iterates through an algorithm involving magnitude comparisons of the RCND register versus the working result plus bit vector summation, conditional decrementing of the radicand, a 1-bit right shift of the result, and a 2-bit right shift of the one-hot bit vector.

Processing two bits of the radicand per cycle, the result register finishes with the integer portion of the square root calculation. The module includes early termination logic so that the execution time is data dependent, based on the magnitude of the input radicand. See Table 6-5 for more execution time details. Since both algorithms share common hardware structures, the incremental cost of the square root logic is an extremely small delta to the basic divide hardware.

The square root algorithm was exhaustively compared (that is, all 2^{32} possible input values) against the standard GNU C library implementation, which converts the unsigned integer input into a double-precision floating-point number, calculates the doubleprecision square root and then converts it back into an unsigned integer. Each input value calculated identical square root results.

6.5.1.2.2 Square root using Q notation

Consider the use of Q notation for square root calculations returning fractional values. The following description is taken from http://en.wikipedia.org/wiki/Q_(number_format).

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018 **NXP Semiconductors** 91

Integer square root

Q is a fixed point number format where the number of fractional bits (and optionally the number of integer bits) is specified. For example, a Q15 number has 15 fractional bits; a Q1.14 number has 1 integer bit and 14 fractional bits. Q format is often used in hardware that does not have a floating-point unit and in applications that require constant resolution.

Q format numbers are (notionally) fixed point numbers (but not actually a number itself); that is, they are stored and operated upon as regular binary numbers (i.e. signed integers), thus allowing standard integer hardware/ALU to perform rational number calculations. The number of integer bits, fractional bits and the underlying word size are to be chosen by the programmer on an application-specific basis - the programmer's choices of the foregoing will depend on the range and resolution needed for the numbers. The machine itself remains oblivious to the notional fixed point representation being employed - it merely performs integer arithmetic the way it knows how. Ensuring that the computational results are valid in the Q format representation is the responsibility of the programmer.

The Q notation is written as Qm.n, where:

- *Q* designates that the number is in the *Q* format notation the Texas Instruments representation for signed fixed-point numbers (the "Q" being reminiscent of the standard symbol for the set of rational numbers).
- *m is the number of bits set aside to designate the two's complement integer portion of the number, exclusive of the sign bit (therefore if m is not specified it is taken as zero).*
- n is the number of bits used to designate the fractional portion of the number, i.e. the number of bits to the right of the binary point. (If n = 0, the Q numbers are integers the degenerate case).

Note that the most significant bit is always designated as the sign bit (the number is stored as a two's complement number) in order to allow standard arithmetic-logic hardware to manipulate Q numbers. Representing a signed fixed-point data type in Q format therefore always requires m+n+1 bits to account for the sign bit. Hence the smallest machine word size required to accommodate a Qm.n number is m+n+1, with the Q number left justified in the machine word.

For a given Qm.n format, using an m+n+1 bit signed integer container with n fractional bits:

- its range is $[-2^m, 2^m 2^{-n}]$
- its resolution is 2⁻ⁿ

For the unsigned integer format used in the MMDVSQ's square root calculation, an u(nsigned)Qm.n notation requires m+n bits (m+n=32) for the input radicand. An uQm.n format produces an uQ(m/2).(n/2) square root. As examples, consider the following tables involving the square root of 2 and square root of "pi" calculations. As expected, as the number of fractional bits (n) increases, the error between the calculated square root and the "actual" result decreases.

RCND [Hex]	RCND Q format	Results [Hex]	RES Q Format	Decimal	% Error
0x0000_0002	uQ32.00	0x0000_0001	uQ16.00	1.0	-29.289%
0x0002_0000	uQ16.16	0x0000_016A	uQ08.08	1.4140625	-0.011%
0x0200_0000	uQ08.24	0x0000_16A0	uQ04.12	1.4140625	-0.011%
0x2000_0000	uQ04.28	0x0000_5A82	uQ02.14	1.4141845703	-0.002%
0x8000_0000	uQ02.30	0x0000_B504	uQ01.15	1.4141845703	-0.002%

Table 6-2. Square Root of 2 Calculations ($\sqrt{2} = 1.4142135623$)

Table 6-3. Square Root of Pi Calculations (,/Pi = 1.7724538509)

RCND [Hex]	RCND Q format	Results [Hex]	RES Q Format	Decimal	% Error
0x0000_0003	uQ32.0	0x0000_0001	uQ16.00	1.0	-43.581%
0x0003_243F	uQ16.16	0x0000_01C5	uQ08.08	1.76953125	-0.165%
0x0324_3F6A	uQ08.24	0x0000_1C5B	uQ04.12	1.772216769	-0.013%
0x3243_F6A8	uQ04.28	0x0000_716F	uQ02.14	1.7723999023	-0.003%
0xC90F_DAA0	uQ02.30	0x0000_E2DF	uQ01.15	1.7724304199	-0.001%

The application of the Q notation for square root calculations provides a powerful extension for these types of fractional numeric computations using fixed-point integer processing hardware.

6.5.2 Execution times

The MMDVSQ module includes early termination logic to finish both divide and square root calculations as quickly as possible, based on the magnitude of the input operand. Accordingly, the execution time for the calculations is data dependent as defined in Table 6-4 and Table 6-5. In this context, the execution time is defined from the register write to initiate the calculation until the result register has been updated and available to read. Stated differently, it represents the time CSR[BUSY] is asserted for a given calculation. In the following two tables, "x" signals a bit with a don't care value.

NXP Semiconductors

93

Table 6-4. Divide Execution Times

CSR[USGN] ? DEND[31:0] // unsigned divide : abs(DEND[31:0]) // signed divide	Execution Time with CSR[BUSY] = 1 [cycles]
(01,1x)xx_xxxx_xxxx_xxxx_xxxx_xxxxxxxxxxxx	17
00(01,1x)_xxxx_xxxx_xxxx_xxxx_xxxx_xxxx	16
0000_(01,1x)xx_xxxx_xxxx_xxxx_xxxx_xxxx	15
0000_00(01,1x)_xxxx_xxxx_xxxx_xxxx_xxxx	14
0000_0000_(01,1x)xx_xxxxxxxx_xxxx_xxxx	13
0000_0000_00(01,1x)_xxxxxxxx_xxxx_xxxx	12
0000_0000_0000_(01,1x)xxxxxx_xxxx_xxxx_xxxx	11
0000_0000_0000_00(01,1x)xxxx_xxxx_xxxx_xxxx	10
0000_0000_0000_0000(01,1x)xx_xxxx_xxxx_xxxx	9
0000_0000_0000_000000(01,1x)_xxxx_xxxx_xxxx	8
0000_0000_0000_00000000_(01,1x)xx_xxxx_xxxx	7
0000_0000_0000_00000000_00(01,1x)_xxxx_xxxx	6
0000_0000_0000_0000_0000_0000_(01,1x)xx_xxxx	5
0000_0000_0000_0000_0000_00(01,1x)_xxxx	4
0000_0000_0000_0000_0000_0000_0000_(01,1x)xx	3
0000_0000_0000_0000_0000_0000_0000_00(01,1x)	2
0000_0000_0000_0000_0000_0000_0000	1

Table 6-5. Square Root Execution Times

RCND[31:0]	Execution Time with CSR[BUSY] = 1 [cycles]
(01,1x)xx_xxxx_xxxx_xxxx_xxxx_xxxx	17
00(01,1x)_xxxx_xxxx_xxxx_xxxx_xxxx_xxxx	16
0000_(01,1x)xx_xxxx_xxxx_xxxx_xxxx_xxxx	15
0000_00(01,1x)_xxxx_xxxx_xxxx_xxxx_xxxx	14
0000_0000_(01,1x)xx_xxxxxxxx_xxxx_xxxx	13
0000_0000_00(01,1x)_xxxxxxxx_xxxx_xxxx_xxxx	12
0000_0000_0000_(01,1x)xxxxxx_xxxx_xxxx_xxxx	11
0000_0000_0000_00(01,1x)xxxx_xxxx_xxxx_xxxx	10
0000_0000_0000_0000(01,1x)xx_xxxx_xxxx_xxxx	9
0000_0000_0000_000000(01,1x)_xxxx_xxxxx_xxxx	8
0000_0000_0000_00000000_(01,1x)xx_xxxx_xxxx	7
0000_0000_0000_00000000_00(01,1x)_xxxx_xxxx	6
0000_0000_0000_0000_0000_(01,1x)xx_xxxx	5
0000_0000_0000_0000_0000_00(01,1x)_xxxx	4
0000_0000_0000_0000_0000_0000_(01,1x)xx	3
0000_0000_0000_0000_0000_0000_00(01,1x)	2
0000_0000_0000_0000_0000_0000_0000	2

6.5.3 Software interface

The programming model of the MMDVSQ is organized to be similar to the input arguments passed to software libraries for integer divide and square root functions.

6.5.3.1 Operation activation and result retrieval

The MMDVSQ supports 2 mechanisms for initiating a divide operation:

- The default mechanism is a "fast start" where a write to the DSOR register begins the divide.
- Alternatively, the start mechanism can begin after a write to the CSR register with the CSR[SRT] set.

The CSR[DFS] indicator selects the divide start mechanism.

```
if CSR[DFS] = 0
    then a divide is initiated by a write to the DSOR register
    else a divide is initiated by a write to the CSR register with CSR[SRT] = 1
```

A square root calculation is initiated by a write to the RCND register.

For both divide and square root calculations, the result of the operation is retrieved by reading the RES register. A memory read of this register while the calculation is still being performed causes the access to be stalled via the insertion of bus wait states until the new result is loaded into the register. Note a stalled bus cycle cannot be interrupted, so if system interrupt latency is a concern, the processor should execute a simple wait loop, for example, polling CSR[BUSY], before reading the RES register. This code construct is fully interruptible, so interrupt latency is minimized.

6.5.3.2 Context save and restore

Given that multiple memory-mapped register accesses are needed for each divide and square root calculation, interrupts may occur during the required sequence of operations. As a result, the MMDVSQ's programming model can be saved at entry to an interrupt service routine (ISR) and then restored when redispatching to the interrupted task.

The module's context can be saved by reading the DEND, DSOR, CSR, and RES registers and storing them as part of the task state. There is one special consideration for the task state save. If the last calculation was a zero divide and the divide-by-zero enable is set (CSR[DZE] = 1), then a read of the RES register is error terminated. To avoid a zero-divide error termination during a context save, the following sequence can be used:

1. Read DEND, DSOR, and CSR registers and save the values as part of the task state.

Integer square root

- 2. Clear CSR[DZE].
- 3. Read the RES register and save its value as part of the task state.

When restoring the context, special care must be taken to not initiate another divide calculation. Specifically, CSR[DFS] must be set first before reloading the DEND and DSOR registers. For example, the following sequence can be used for the context reload:

- 1. Write 0x0000 0020 to the CSR to disable the fast start mechanism.
- 2. Reload DEND, DSOR, CSR, and RES registers from the saved state.

Since the original context save of the control/status register is guaranteed to have CSR[SRT] = 0, there is no divide operation initiated when this register is reloaded in step 2.

Chapter 7 Miscellaneous Control Module (MCM)

7.1 Chip-specific Information for this Module

A generic block diagram of the processor core and platform for this class of microcontrollers is shown in the following figure. The MCM module's location is highlighted.

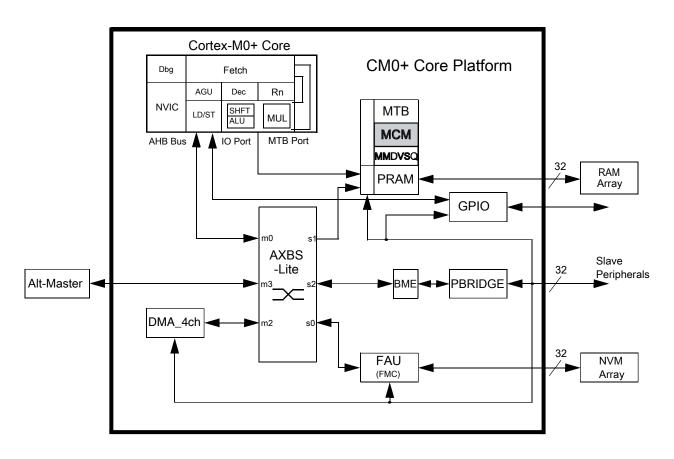


Figure 7-1. Cortex-M0+ core platform block diagram

7.2 Introduction

The Miscellaneous Control Module (MCM) provides a myriad of miscellaneous control functions.

7.2.1 **Features**

The MCM includes the following features:

- Program-visible information on the platform configuration
- Crossbar master arbitration policy selection
- Flash controller speculation buffer and cache configurations

Memory map/register descriptions

The memory map and register descriptions found here describe the registers using byte addresses. The registers can be written only when in supervisor mode.

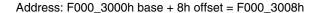
MCM memory map

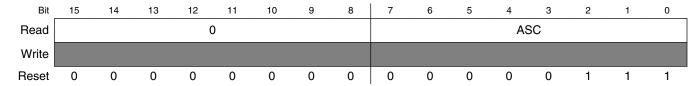
Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page
F000_3008	Crossbar Switch (AXBS) Slave Configuration (MCM_PLASC)	16	R	0007h	7.3.1/99
F000_300A	Crossbar Switch (AXBS) Master Configuration (MCM_PLAMC)	16	R	0005h	7.3.2/99
F000_300C	Platform Control Register (MCM_PLACR)	32	R/W	0000_0250h	7.3.3/100
F000_3040	Compute Operation Control Register (MCM_CPO)	32	R/W	0000_0000h	7.3.4/103

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018 98 **NXP Semiconductors**

7.3.1 Crossbar Switch (AXBS) Slave Configuration (MCM_PLASC)

PLASC is a 16-bit read-only register identifying the presence/absence of bus slave connections to the device's crossbar switch.





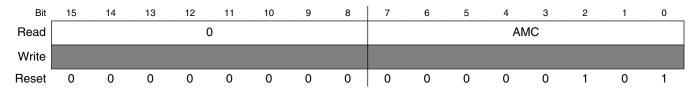
MCM_PLASC field descriptions

Field	Description
15–8 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
ASC	Each bit in the ASC field indicates whether there is a corresponding connection to the crossbar switch's slave input port.
	 0 A bus slave connection to AXBS input port <i>n</i> is absent. 1 A bus slave connection to AXBS input port <i>n</i> is present.

7.3.2 Crossbar Switch (AXBS) Master Configuration (MCM_PLAMC)

PLAMC is a 16-bit read-only register identifying the presence/absence of bus master connections to the device's crossbar switch.

Address: F000_3000h base + Ah offset = F000_300Ah



MCM_PLAMC field descriptions

Field	Description
15–8 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
AMC	Each bit in the AMC field indicates whether there is a corresponding connection to the AXBS master input port.

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Memory map/register descriptions

MCM_PLAMC field descriptions (continued)

Field	Description
	0 A bus master connection to AXBS input port <i>n</i> is absent
	1 A bus master connection to AXBS input port <i>n</i> is present

7.3.3 Platform Control Register (MCM_PLACR)

The PLACR register selects the arbitration policy for the crossbar masters and configures the flash memory controller.

The speculation buffer and cache in the flash memory controller is configurable via PLACR[15:10].

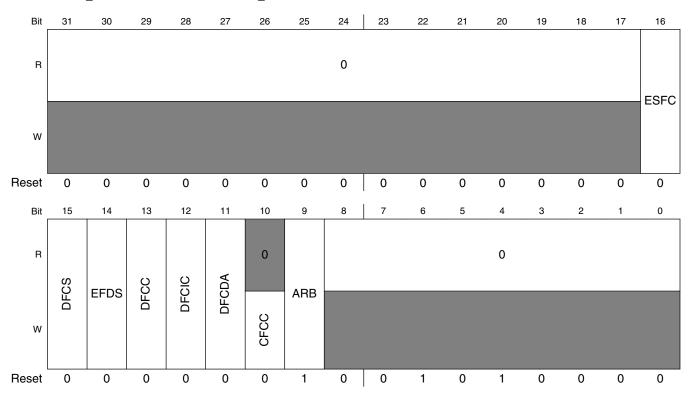
The speculation buffer is enabled only for instructions after reset. It is possible to have these states for the speculation buffer:

DFCS	EFDS	Description
0	0	Speculation buffer is on for instruction and off for data.
0	1	Speculation buffer is on for instruction and on for data.
1	X	Speculation buffer is off.

The cache in flash controller is enabled and caching both instruction and data type fetches after reset. It is possible to have these states for the cache:

DFCC	DFCIC	DFCDA	Description
0	0	0	Cache is on for both instruction and data.
0	0	1	Cache is on for instruction and off for data.
0	1	0	Cache is off for instruction and on for data.
0	1	1	Cache is off for both instruction and data.
1	Х	Х	Cache is off.

Address: F000_3000h base + Ch offset = F000_300Ch



MCM_PLACR field descriptions

Field	Description
31–17	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
16 ESFC	Enable Stalling Flash Controller
Loro	Enables stalling flash controller when flash is busy.
	When software needs to access the flash memory while a flash memory resource is being manipulated by a flash command, software can enable a stall mechanism to avoid a read collision. The stall mechanism allows software to execute code from the same block on which flash operations are being performed. However, software must ensure the sector the flash operations are being performed on is not the same sector from which the code is executing.
	ESFC enables the stall mechanism. This bit must be set only just before the flash operation is executed and must be cleared when the operation completes.
	0 Disable stalling flash controller when flash is busy.
	1 Enable stalling flash controller when flash is busy.
15 DFCS	Disable Flash Controller Speculation
	Disables flash controller speculation.
	0 Enable flash controller speculation.
	1 Disable flash controller speculation.
14 EFDS	Enable Flash Data Speculation
	Enables flash data speculation.

Table continues on the next page...

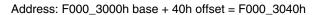
Memory map/register descriptions

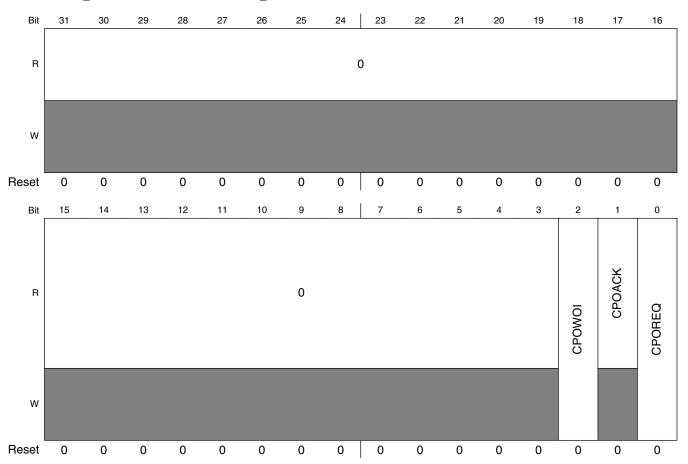
MCM_PLACR field descriptions (continued)

Field	Description
	0 Disable flash data speculation.
	1 Enable flash data speculation.
13 DFCC	Disable Flash Controller Cache
	Disables flash controller cache.
	0 Enable flash controller cache.
	1 Disable flash controller cache.
12 DFCIC	Disable Flash Controller Instruction Caching
	Disables flash controller instruction caching.
	0 Enable flash controller instruction caching.
	1 Disable flash controller instruction caching.
11 DFCDA	Disable Flash Controller Data Caching
	Disables flash controller data caching.
	0 Enable flash controller data caching
	1 Disable flash controller data caching.
10	Clear Flash Controller Cache
CFCC	Writing a 1 to this field clears the cache. Writing a 0 to this field is ignored. This field always reads as 0.
9 ARB	Arbitration select
71112	0 Fixed-priority arbitration for the crossbar masters
	1 Round-robin arbitration for the crossbar masters
Reserved	This field is reserved.
	This read-only field is reserved and always has the value 0.

7.3.4 Compute Operation Control Register (MCM_CPO)

This register controls the Compute Operation.





MCM_CPO field descriptions

Field	Description
31–3 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
2 CPOWOI	Compute Operation Wake-up on Interrupt 0 No effect. 1 When set, the CPOREQ is cleared on any interrupt or exception vector fetch.
1 CPOACK	Compute Operation Acknowledge 0 Compute operation entry has not completed or compute operation exit has completed. 1 Compute operation entry has completed or compute operation exit has not completed.
0 CPOREQ	Compute Operation Request This bit is auto-cleared by vector fetching if CPOWOI = 1.

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Memory map/register descriptions

MCM_CPO field descriptions (continued)

Field	Description	
	0 Request is cleared.	
	1 Request Compute Operation.	

AND O

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Chapter 8 Bit Manipulation Engine (BME)

8.1 Chip-specific Information for this Module

In this block chapter, PBRIDGE stands for the Peripheral Bridge, with the same meaning as AIPS-Lite.

8.2 Introduction

The Bit Manipulation Engine (BME) provides hardware support for atomic read-modify-write memory operations to the peripheral address space in Cortex-M0+ based microcontrollers.

This architectural capability is also known as "decorated storage" as it defines a mechanism for providing additional semantics for load and store operations to memory-mapped peripherals beyond just the reading and writing of data values to the addressed memory locations. In the BME definition, the "decoration", that is, the additional semantic information, is encoded into the peripheral address used to reference the memory.

By combining the basic load and store instructions of the Arm Cortex-M instruction set architecture (v6M, v7M) with the concept of decorated storage provided by the BME, the resulting implementation provides a robust and efficient read-modify-write capability to this class of ultra low-end microcontrollers. The resulting architectural capability defined by this core platform function is targeted at the manipulation of n-bit fields in peripheral registers and is consistent with I/O hardware addressing in the Embedded C standard. For most BME commands, a single core read or write bus cycle is converted into an atomic read-modify-write, that is, an indivisible "read followed by a write" bus sequence.

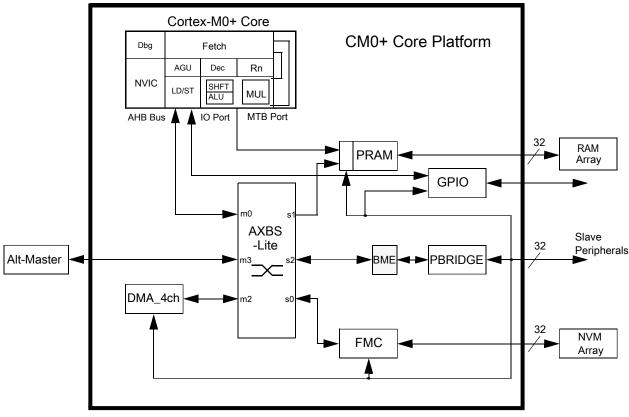
BME decorated references are only available on system bus transactions generated by the processor core and targeted at the standard 512 KB peripheral address space based at $0x4000_0000^1$. The decoration semantic is embedded into address bits[28:19], creating a

Introduction

448 MB space at addresses 0x4400_0000–0x5FFF_FFFF for AIPS; these bits are stripped out of the actual address sent to the peripheral bus controller and used by the BME to define and control its operation.

8.2.1 Overview

The following figure is a generic block diagram of the processor core and platform for this class of ultra low-end microcontrollers.



Note: BME can be accessed only by the core.

Figure 8-1. Cortex-M0+ core platform block diagram

As shown in the block diagram, the BME module interfaces to a switch AHB slave port as its primary input and sources an AHB bus output to the Peripheral Bridge (PBRIDGE) controller. The BME hardware microarchitecture is a 2-stage pipeline design matching

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

To be perfectly accurate, the peripheral address space occupies a 516 KB region: 512 KB based at 0x4000_0000 plus a 4 KB space based at 0x400F_F000 for GPIO accesses. This organization provides compatibility with the Kinetis K Family. Attempted accesses to the memory space located between 0x4008_0000 - 0x400F_EFFF are error terminated due to an illegal address.

the protocol of the AMBA-AHB system bus interfaces. The PBRIDGE module converts the AHB system bus protocol into the IPS/APB protocol used by the attached slave peripherals.

8.2.2 Features

The key features of the BME include:

- Lightweight implementation of decorated storage for selected address spaces
- Additional access semantics encoded into the reference address
- Resides between a switch slave port and a peripheral bridge bus controller
- Two-stage pipeline design matching the AHB system bus protocol
- Combinationally passes non-decorated accesses to peripheral bridge bus controller
- Conversion of decorated loads and stores from processor core into atomic readmodify-writes
- Decorated loads support unsigned bit field extracts, load-and-{set,clear} 1-bit operations
- Decorated stores support bit field inserts, logical AND, OR, and XOR operations
- Support for byte, halfword and word-sized decorated operations
- Supports minimum signal toggling on AHB output bus to reduce power dissipation

8.2.3 Modes of operation

The BME module does not support any special modes of operation. As a memory-mapped device located on a crossbar slave AHB system bus port, BME responds strictly on the basis of memory addresses for accesses to the peripheral bridge bus controller.

All functionality associated with the BME module resides in the core platform's clock domain; this includes its connections with the crossbar slave port and the PBRIDGE bus controller.

8.3 Memory map and register definition

The BME module provides a memory-mapped capability and does not include any programming model registers.

The exact set of functions supported by the BME are detailed in the Functional description.

Functional description

The peripheral address space occupies a 516 KB region: 512 KB based at 0x4000_0000 plus a 4 KB space based at 0x400F_F000 for GPIO accesses; the decorated address space is mapped to the 448 MB region located at 0x4400_0000-0x5FFF_FFFF.

8.4 Functional description

Information found here details the specific functions supported by the BME.

Recall the combination of the basic load and store instructions of the Cortex-M instruction set architecture (v6M, v7M) plus the concept of decorated storage provided by the BME, the resulting implementation provides a robust and efficient read-modify-write capability to this class of ultra low-end microcontrollers. The resulting architectural capability defined by this core platform function is targeted at the manipulation of n-bit fields in peripheral registers and is consistent with I/O hardware addressing in the Embedded C standard. For most BME commands, a single core read or write bus cycle is converted into an atomic read-modify-write, that is, an indivisible "read followed by a write" bus sequence.

Consider decorated store operations first, then decorated loads.

8.4.1 BME decorated stores

The functions supported by the BME's decorated stores include three logical operators (AND, OR, XOR) plus a bit field insert.

For all these operations, BME converts a single decorated AHB store transaction into a 2-cycle atomic read-modify-write sequence, where the combined read-modify operation is performed in the first AHB data phase, and then the write is performed in the second AHB data phase.

A generic timing diagram of a decorated store showing a peripheral bit field insert operation is shown as follows:

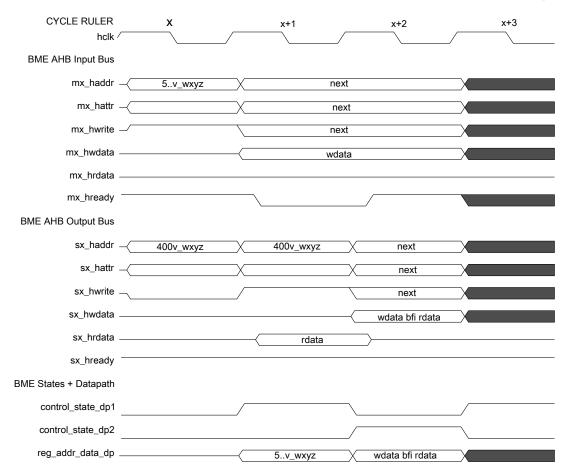


Figure 8-2. Decorated store: bit field insert timing diagram

All the decorated store operations follow the same execution template shown in Figure 8-2, a two-cycle read-modify-write operation:

- 1. Cycle x, 1st AHB address phase: Write from input bus is translated into a read operation on the output bus using the actual memory address (with the decoration removed) and then captured in a register.
- 2. Cycle x+1, 2nd AHB address phase: Write access with the registered (but actual) memory address is output
- 3. Cycle x+1, 1st AHB data phase: Memory read data is modified using the input bus write data and the function defined by the decoration and captured in a data register; the input bus cycle is stalled.
- 4. Cycle x+2, 2nd AHB data phase: Registered write data is sourced onto the output write data bus.

NOTE

Any wait states inserted by the slave device are simply passed through the BME back to the master input bus, stalling the AHB transaction cycle for cycle.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

8.4.1.1 Decorated store logical AND (AND)

This command performs an atomic read-modify-write of the referenced memory location.

- 1. First, the location is read;
- 2. It is then modified by performing a logical AND operation using the write data operand sourced for the system bus cycle
- 3. Finally, the result of the AND operation is written back into the referenced memory location.

The data size is specified by the write operation and can be byte (8-bit), halfword (16-bit) or word (32-bit). The core performs the required write data lane replication on byte and halfword transfers.

_	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
ioandb	0	*	*	0	0	1	1	1	-	-	-	-								r	nen	1_a	ddr									
ioandh	0	*	*	0	0	1	1	1	-	1	-	1								r	nen	n_a	ddr									0
ioandw	0	*	*	0	0	1	1	1	-	1	-	1								r	nen	1_a	ddr								0	0

Figure 8-3. Decorated store address: logical AND

See Figure 8-3, where addr[30:29] = 10 for peripheral, addr[28:26] = 001 specifies the AND operation, and mem_addr[19:0] specifies the address offset into the space based at 0x4000_0000 for peripherals. The "-" indicates an address bit "don't care".

The decorated AND write operation is defined in the following pseudo-code as:

where the operand size <sz> is defined as b(yte, 8-bit), h(alfword, 16-bit) and w(ord, 32-bit). This notation is used throughout the document.

In the cycle definition tables, the notations AHB_ap and AHB_dp refer to the address and data phases of the BME AHB transaction. The cycle-by-cycle BME operations are detailed in the following table.

Pipeline stage		Cycle	
	х	x+1	x+2
BME AHB_ap	1	Recirculate captured addr + attr to memory as slave_wt	<next></next>

Table 8-1. Cycle definitions of decorated store: logical AND

Table continues on the next page...

Table 8-1. Cycle definitions of decorated store: logical AND (continued)

Pipeline stage		Cycle	
	х	x+1	x+2
	master_wt to slave_rd; Capture address, attributes		
BME AHB_dp	<pre><previous></previous></pre>	Perform memory read; Form (rdata & wdata) and capture destination data in register	Perform write sending registered data to memory

8.4.1.2 Decorated store logical OR (OR)

This command performs an atomic read-modify-write of the referenced memory location.

- 1. First, the location is read.
- 2. It is then modified by performing a logical OR operation using the write data operand sourced for the system bus cycle.
- 3. Finally, the result of the OR operation is written back into the referenced memory location.

The data size is specified by the write operation and can be byte (8-bit), halfword (16-bit) or word (32-bit). The core performs the required write data lane replication on byte and halfword transfers.

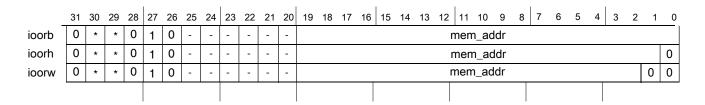


Figure 8-4. Decorated address store: logical OR

See Figure 8-4,where addr[30:29] = 10 for peripheral, addr[28:26] = 010 specifies the OR operation, and mem_addr[19:0] specifies the address offset into the space based at $0x4000_0000$ for peripherals. The "-" indicates an address bit "don't care".

The decorated OR write operation is defined in the following pseudo-code as:

The cycle-by-cycle BME operations are detailed in the following table.

NO. 1 1 1

Table 8-2. Cycle definitions of decorated store: logical OR

Pipeline stage		Cycle	
	х	x+1	x+2
BME AHB_ap	Forward addr to memory; Decode decoration; Convert master_wt to slave_rd; Capture address, attributes	Recirculate captured addr + attr to memory as slave_wt	<next></next>
BME AHB_dp	<previous></previous>	Perform memory read; Form (rdata I wdata) and capture destination data in register	Perform write sending registered data to memory

8.4.1.3 Decorated store logical XOR (XOR)

This command performs an atomic read-modify-write of the referenced memory location.

- 1. First, the location is read.
- 2. It is then modified by performing a logical XOR (exclusive-OR) operation using the write data operand sourced for the system bus cycle.
- 3. Finally, the result of the XOR operation is written back into the referenced memory location.

The data size is specified by the write operation and can be byte (8-bit), halfword (16-bit) or word (32-bit). The core performs the required write data lane replication on byte and halfword transfers.

	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
ioxorb	0	*	*	0	1	1	1	1	1	1	1						-			r	ner	n_a	ddr		-							
ioxorh	0	*	*	0	1	1	1	-	1	-	,	-	mem_addr											0								
ioxorw	0	*	*	0	1	1	1	1	1	1	,	1								r	nen	n_a	ddr								0	0

Figure 8-5. Decorated address store: logical XOR

See Figure 8-5, where addr[30:29] =10 for peripheral, addr[28:26] = 011 specifies the XOR operation, and mem_addr[19:0] specifies the address offset into the peripheral space based at 0x4000_0000 for peripherals. The "-" indicates an address bit "don't care".

The decorated XOR write operation is defined in the following pseudo-code as:

The cycle-by-cycle BME operations are detailed in the following table.

Table 8-3.	Cycle definitions of	decorated store: logical XOR
-------------------	----------------------	------------------------------

Pipeline Stage		Cycle	
	х	x+1	x+2
BME AHB_ap	Forward addr to memory; Decode decoration; Convert master_wt to slave_rd; Capture address, attributes	Recirculate captured addr + attr to memory as slave_wt	<next></next>
BME AHB_dp	<pre><pre><pre><pre></pre></pre></pre></pre>	Perform memory read; Form (rdata ^ wdata) and capture destination data in register	Perform write sending registered data to memory

8.4.1.4 Decorated store bit field insert (BFI)

This command inserts a bit field contained in the write data operand, defined by LSB position (b) and the bit field width (w+1), into the memory "container" defined by the access size associated with the store instruction using an atomic read-modify-write sequence.

The data size is specified by the write operation and can be byte (8-bit), halfword (16-bit) or word (32-bit).

NOTE

For the word sized operation, the maximum bit field width is 16 bits. The core performs the required write data lane replication on byte and halfword transfers.

The BFI operation can be used to insert a single bit into a peripheral. For this case, the w field is simply set to 0, indicating a bit field width of 1.

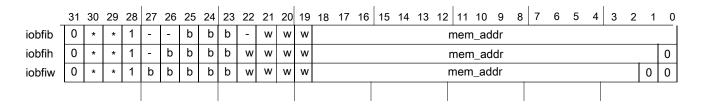


Figure 8-6. Decorated address store: bit field insert

where addr[30:29] =10 for peripheral,addr[28] = 1 signals a BFI operation, addr[27:23] is "b", the LSB identifier, addr[22:19] is "w", the bit field width minus 1 identifier, and addr[18:0] specifies the address offset into the peripheral space based at 0x4000_0000 for peripherals. The "-" indicates an address bit "don't care". Note, unlike the other decorated store operations, BFI uses addr[19] as the least significant bit in the "w" specifier and not as an address bit.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Functional description

The decorated BFI write operation is defined in the following pseudo-code as:

The write data operand (wdata) associated with the store instruction contains the bit field to be inserted. It must be properly aligned within a right-aligned container, that is, within the lower 8 bits for a byte operation, the lower 16 bits for a halfword, or the entire 32 bits for a word operation.

To illustrate, consider the following example of the insertion of the 3-bit field "xyz" into an 8-bit memory container, initially set to "abcd_efgh". For all cases, w is 2, signaling a bit field width of 3.

```
if b = 0 and the decorated store (strb) Rt register[7:0] = ---- -xyz,
  then destination is "abcd exyz"
if b = 1 and the decorated store (strb) Rt register[7:0] = ---- xyz-,
  then destination is "abcd xyzh"
if b = 2 and the decorated store (strb) Rt register[7:0] = ---x yz--,
  then destination is "abcx yzgh"
if b = 3 and the decorated store (strb) Rt register[7:0] = --xy z---,
  then destination is "abxy_zfgh"
if b = 4 and the decorated store (strb) Rt register[7:0] = -xyz ----,
  then destination is "axyz_efgh"
if b = 5 and the decorated store (strb) Rt register[7:0] = xyz-_---,
  then destination is "xyzd_efgh"
if b = 6 and the decorated store (strb) Rt register[7:0] = yz-- ----,
  then destination is "yzcd efgh"
if b = 7 and the decorated store (strb) Rt register[7:0] = z--- ---,
   then destination is "zbcd efgh"
```

Note from the example, when the starting bit position plus the field width exceeds the container size, only part of the source bit field is inserted into the destination memory location. Stated differently, if $(b + w+1) > \text{container_width}$, only the low-order "container_width - b" bits are actually inserted.

The cycle-by-cycle BME operations are detailed in the following table.

Pipeline stage		Cycle	
	х	x+1	x+2
BME AHB_ap	Forward addr to memory; Decode decoration; Convert master_wt to slave_rd; Capture address, attributes	Recirculate captured addr + attr to memory as slave_wt	<next></next>
BME AHB_dp	<pre><previous></previous></pre>	Perform memory read; Form bit mask; Form bitwise ((mask)? wdata: rdata)) and capture destination data in register	Perform write sending registered data to memory

Table 8-4. Cycle definitions of decorated store: bit field insert

115

8.4.2 BME decorated loads

The functions supported by the BME's decorated loads include two single-bit load-and-{set, clear} operators plus unsigned bit field extracts.

For the two load-and-{set, clear} operations, BME converts a single decorated AHB load transaction into a two-cycle atomic read-modify-write sequence, where the combined read-modify operations are performed in the first AHB data phase, and then the write is performed in the second AHB data phase as the original read data is returned to the processor core. For an unsigned bit field extract, the decorated load transaction is stalled for one cycle in the BME as the data field is extracted, then aligned and returned to the processor in the second AHB data phase. This is the only decorated transaction that is not an atomic read-modify-write, as it is a simple data read.

A generic timing diagram of a decorated load showing a peripheral load-and-set 1-bit operation is shown as follows.

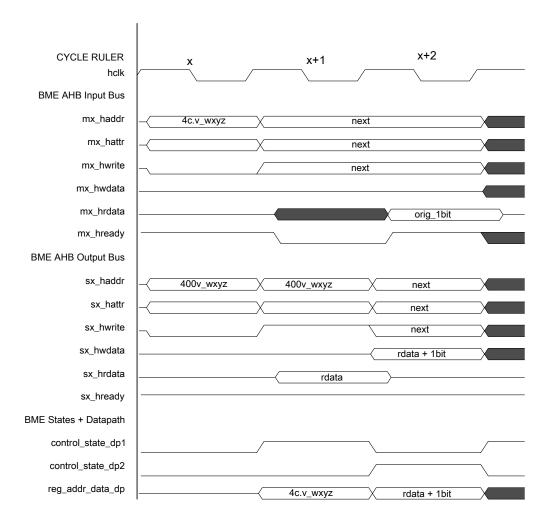


Figure 8-7. Decorated load: load-and-set 1-bit field insert timing diagram

Decorated load-and-{set, clear} 1-bit operations follow the execution template shown in the above figure: a 2-cycle read-modify-write operation:

- 1. Cycle x, first AHB address phase: Read from input bus is translated into a read operation on the output bus with the actual memory address (with the decoration removed) and then captured in a register
- 2. Cycle x+1, second AHB address phase: Write access with the registered (but actual) memory address is output
- 3. Cycle x+1, first AHB data phase: The "original" 1-bit memory read data is captured in a register, while the 1-bit field is set or clear based on the function defined by the decoration with the modified data captured in a register; the input bus cycle is stalled
- 4. Cycle x+2, second AHB data phase: The selected original 1-bit is right-justified, zero-filled and then driven onto the input read data bus, while the registered write data is sourced onto the output write data bus

NOTE

Any wait states inserted by the slave device are simply passed through the BME back to the master input bus, stalling the AHB transaction cycle for cycle.

A generic timing diagram of a decorated load showing an unsigned peripheral bit field operation is shown in the following figure.

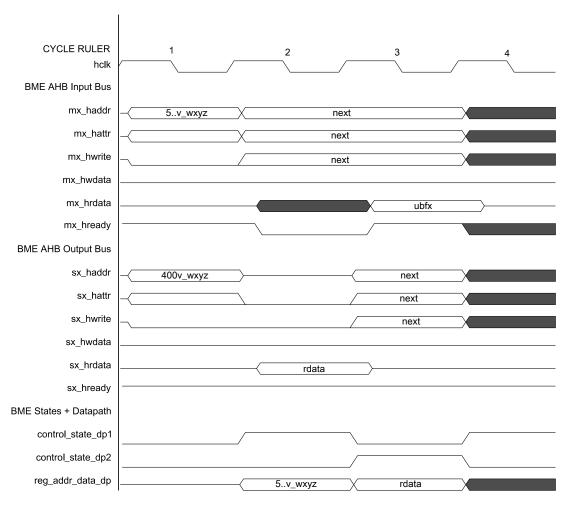


Figure 8-8. Decorated load: unsigned bit field insert timing diagram

The decorated unsigned bit field extract follows the same execution template shown in the above figure, a 2-cycle read operation:

- Cycle x, 1st AHB address phase: Read from input bus is translated into a read operation on the output bus with the actual memory address (with the decoration removed) and then captured in a register
- Cycle x+1, 2nd AHB address phase: Idle cycle

Functional description

- Cycle x+1, 1st AHB data phase: A bit mask is generated based on the starting bit position and the field width; the mask is AND'ed with the memory read data to isolate the bit field; the resulting data is captured in a data register; the input bus cycle is stalled
- Cycle x+2, 2nd AHB data phase: Registered data is logically right-aligned for proper alignment and driven onto the input read data bus

NOTE

Any wait states inserted by the slave device are simply passed through the BME back to the master input bus, stalling the AHB transaction cycle for cycle.

8.4.2.1 Decorated load: load-and-clear 1 bit (LAC1)

This command loads a 1-bit field defined by the LSB position (b) into the core's general purpose destination register (Rt) and zeroes the bit in the memory space after performing an atomic read-modify-write sequence.

The extracted 1-bit data field from the memory address is right-justified and zero-filled in the operand returned to the core.

The data size is specified by the read operation and can be byte (8-bit), halfword (16-bit) or word (32-bit).

	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
iolaclb	0	*	*	0	1	0	-	-	b	b	b	-									m	em_	_ad	dr								
iolaclh	0	*	*	0	1	0	-	b	b	b	b	-									m	em_	_ad	dr								0
iolaclw	0	*	*	0	1	0	b	b	b	b	b	-									m	em.	_ad	dr							0	0

Figure 8-9. Decorated load address: load-and-clear 1 bit

See Figure 8-9, where addr[30:29] = 10 for peripheral, addr[28:26] = 010 specifies the load-and-clear 1 bit operation, addr[25:21] is "b", the bit identifier, and mem_addr[19:0] specifies the address offset into the space based at $0x4000_0000$ for peripheral. The "-" indicates an address bit "don't care".

The decorated load-and-clear 1-bit read operation is defined in the following pseudo-code as:

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

The cycle-by-cycle BME operations are detailed in the following table.

Pipeline Stage		Cycle	
	х	x+1	x+2
BME AHB_ap	Forward addr to memory; Decode decoration; Capture address, attributes	Recirculate captured addr + attr to memory as slave_wt	<next></next>
BME AHB_dp	<pre><previous></previous></pre>	Perform memory read; Form bit mask; Extract bit from rdata; Form (rdata & ~mask) and capture destination data	Return extracted bit to master; Perform write sending registered data to memory

in register

Table 8-5. Cycle definitions of decorated load: load-and-clear 1 bit

8.4.2.2 Decorated Load: Load-and-Set 1 Bit (LAS1)

This command loads a 1-bit field defined by the LSB position (b) into the core's general purpose destination register (Rt) and sets the bit in the memory space after performing an atomic read-modify-write sequence.

The extracted one bit data field from the memory address is right justified and zero filled in the operand returned to the core.

The data size is specified by the read operation and can be byte (8-bit), halfword (16-bit) or word (32-bit).

	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
iolaslb	0	*	*	0	1	1	1	-	b	b	b	-								r	nen	1_a	ddr									
iolaslh	0	*	*	0	1	1	1	b	b	b	b	-								r	nen	n_a	ddr									0
iolaslw	0	*	*	0	1	1	b	b	b	b	b	-								r	nen	1_a	ddr								0	0

Figure 8-10. Decorated load address: load-and-set 1 bit

where addr[30:29] = 10 for peripheral, addr[28:26] = 011 specifies the load-and-set 1 bit operation, addr[25:21] is "b", the bit identifier, and mem_addr[19:0] specifies the address offset into the space based at $0x4000_0000$ for peripheral. The "-" indicates an address bit "don't care".

The decorated Load-and-Set 1 Bit read operation is defined in the following pseudo-code as:

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Functional description

The cycle-by-cycle BME operations are detailed in the following table.

Table 8-6. Cycle definitions of decorated load: load-and-set 1-bit

Pipeline Stage		Cycle	
	х	x+1	x+2
BME AHB_ap	Forward addr to memory; Decode decoration; Capture address, attributes	Recirculate captured addr + attr to memory as slave_wt	<next></next>
BME AHB_dp	<pre><previous></previous></pre>	Perform memory read; Form bit mask; Extract bit from rdata; Form (rdata I mask) and capture destination data in register	Return extracted bit to master; Perform write sending registered data to memory

8.4.2.3 Decorated load unsigned bit field extract (UBFX)

This command extracts a bit field defined by LSB position (b) and the bit field width (w +1) from the memory "container" defined by the access size associated with the load instruction using a two-cycle read sequence.

The extracted bit field from the memory address is right-justified and zero-filled in the operand returned to the core. Recall this is the only decorated operation that does not perform a memory write, that is, UBFX only performs a read.

The data size is specified by the write operation and can be byte (8-bit), halfword (16-bit) or word (32-bit). Note for the word sized operation, the maximum bit field width is 16 bits.

The use of a UBFX operation is recommended to extract a single bit. For this case, the w field is simply set to 0, indicating a bit field width of 1.

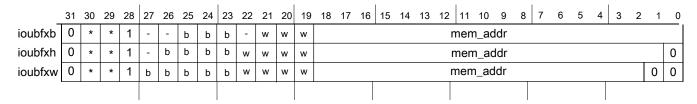


Figure 8-11. Decorated load address: unsigned bit field extract

See Figure 8-11, where addr[30:29] = 10 for peripheral, addr[28] = 1 specifies the unsigned bit field extract operation, addr[27:23] is "b", the LSB identifier, addr[22:19] is "w", the bit field width minus 1 identifier, and mem_addr[18:0] specifies the address

121

offset into the space based at 0x4000_0000 for peripheral. The "-" indicates an address bit "don't care". Note, unlike the other decorated load operations, UBFX uses addr[19] as the least significant bit in the "w" specifier and not as an address bit.

The decorated unsigned bit field extract read operation is defined in the following pseudo-code as:

Like the BFI operation, when the starting bit position plus the field width exceeds the container size, only part of the source bit field is extracted from the destination memory location. Stated differently, if $(b + w+1) > \text{container_width}$, only the low-order "container_width - b" bits are actually extracted. The cycle-by-cycle BME operations are detailed in the following table.

Pipeline Stage	Cycle						
	х	x+1	x+2				
BME AHB_ap	Forward addr to memory; Decode decoration; Capture address, attributes	Idle AHB address phase	<next></next>				
BME AHB_dp	<pre><previous></previous></pre>	Perform memory read; Form bit mask; Form (rdata & mask) and capture destination data in register	Logically right shift registered data; Return justified rdata to master				

Table 8-7. Cycle definitions of decorated load: unsigned bit field extract

8.4.3 Additional details on decorated addresses and GPIO accesses

As previously noted, the peripheral address space occupies a 516 KB region: 512 KB based at 0x4000_0000 plus a 4 KB space based at 0x400F_F000 for GPIO accesses. This memory layout provides compatibility with the Kinetis K Family and provides 129 address "slots", each 4 KB in size.

The GPIO address space is multiply-mapped by the hardware: it appears at the "standard" system address $0x400F_F000$ and is physically located in the address slot corresponding to address $0x4000_F000$. Decorated loads and stores create a slight complication involving accesses to the GPIO. Recall the use of address[19] varies by decorated operation; for AND, OR, XOR, LAC1 and LAS1, this bit functions as a true address bit, while for BFI and UBFX, this bit defines the least significant bit of the "w" bit field specifier.

NXP Semiconductors

Application information

As a result, undecorated GPIO references and decorated AND, OR, XOR, LAC1 and LAS1 operations can use the standard 0x400F_F000 base address, while decorated BFI and UBFX operations must use the alternate 0x4000_F000 base address. Another implementation can simply use 0x400F_F000 as the base address for all undecorated GPIO accesses and 0x4000_F000 as the base address for all decorated accesses. Both implementations are supported by the hardware.

Peripheral address space	Description
0x4000_0000-0x4007_FFFF	Undecorated (normal) peripheral accesses
0x4008_0000-0x400F_EFFF	Illegal addresses; attempted references are aborted and error terminated
0x400F_F000-0x400F_FFFF	Undecorated (normal) GPIO accesses using standard address
0x4010_0000-0x43FF_FFFF	Illegal addresses; attempted references are aborted and error terminated
0x4400_0000-0x4FFF_FFFF	Decorated AND, OR, XOR, LAC1, LAS1 references to peripherals and GPIO based at either 0x4000_F000 or 0x400F_F000
0x5000_0000-0x5FFF_FFF	Decorated BFI, UBFX references to peripherals and GPIO only based at 0x4000_F000

Table 8-8. Decorated peripheral and GPIO address details

8.5 Application information

In this section, GNU assembler macros with C expression operands are presented as examples of the required instructions to perform decorated operations.

This section specifically presents a partial bme.h file defining the assembly language expressions for decorated logical stores: AND, OR, and XOR. Comparable functions for BFI and the decorated loads are more complex and available in the complete BME header file.

These macros use the same function names presented in Functional description.

```
#define IOANDW(ADDR,WDATA)
   __asm("ldr r3, =(1<<26);" r3, %[addr]:"
          "orr
                 r3, %[addr];"
          "mov r2, %[wdata];"
"str r2, [r3];"
          :: [addr] "r" (ADDR), [wdata] "r" (WDATA) : "r2", "r3");
#define IOANDH(ADDR,WDATA)
    _{asm("ldr} r3, = (1 << 26);"
          "orr r3, %[addr];"
          "mov r2, %[wdata];"
          "strh r2, [r3];"
          :: [addr] "r" (ADDR), [wdata] "r" (WDATA) : "r2", "r3");
#define IOANDB(ADDR,WDATA)
    __asm("ldr r3, =(1<<26);"
          "orr r3, %[addr];"
          "mov r2, %[wdata];"
"strb r2, [r3];"
          :: [addr] "r" (ADDR), [wdata] "r" (WDATA) : "r2", "r3");
```

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

123

```
#define IOORW(ADDR,WDATA)
    __asm("ldr
               r3, = (1 << 27);"
                 r3, %[addr];"
          "orr
                r2, %[wdata];"
          "mov
               r2, [r3];"
           :: [addr] "r" (ADDR), [wdata] "r" (WDATA) : "r2", "r3"); \\
#define IOORH(ADDR,WDATA)
    __asm("ldr r3, =(1<<27);"
         "orr
                r3, %[addr];"
         "mov r2, %[wdata];"
          "strh r2, [r3];"
         :: [addr] "r" (ADDR), [wdata] "r" (WDATA) : "r2", "r3");
#define IOORB(ADDR,WDATA)
    asm("ldr r3, = (1 << 27);"
         "orr
              r3, %[addr];"
          "mov
                r2, %[wdata];"
          "strb r2, [r3];"
         :: [addr] "r" (ADDR), [wdata] "r" (WDATA) : "r2", "r3");
#define IOXORW(ADDR,WDATA)
   asm("ldr r3, = (3<<26);"
                 r3, %[addr];"
         "orr
          "mov
               r2, %[wdata];"
          "str
                r2, [r3];"
          :: [addr] "r" (ADDR), [wdata] "r" (WDATA) : "r2", "r3");
#define IOXORH(ADDR,WDATA)
    __asm("ldr r3, =(3<<26);"
                r3, %[addr];"
         "orr
                r2, %[wdata];"
r2, [r3];"
          "mov
          "strh
          :: [addr] "r" (ADDR), [wdata] "r" (WDATA) : "r2", "r3");
#define IOXORB(ADDR, WDATA)
    __asm("ldr r3, =(3<<26);"
          "orr
                 r3, %[addr];"
          "mov
                 r2, %[wdata];"
         "strb r2, [r3];"
          :: [addr] "r" (ADDR), [wdata] "r" (WDATA) : "r2", "r3");
```

Application information

Chapter 9 Crossbar Switch Lite (AXBS-Lite)

9.1 Chip-specific Information for this Module

A generic block diagram of the processor core and platform for this class of microcontrollers is shown in the following figure. The AXBS module's location is highlighted.

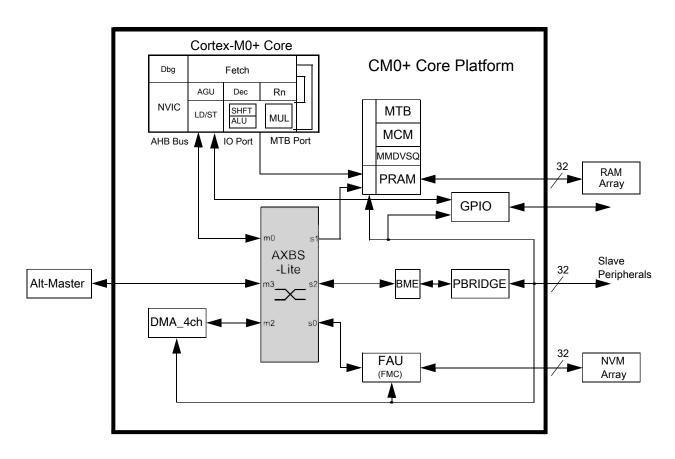


Figure 9-1. Cortex-M0+ core platform block diagram

The masters connected to the crossbar switch are assigned as follows:

Introduction

Master module	Master port number
ARM core I/D bus	0
ARM core system bus	1
DMA	2

The slaves connected to the crossbar switch are assigned as follows:

Slave module	Slave port number
Flash memory controller	0
SRAM controllers	1
Peripheral bridge 0 / GPIO ¹	2

See System memory map for access restrictions.

NOTE

This crossbar switch has no memory mapped configuration registers. The arbitration method in the crossbar switch is programmable by MCM registers.

NOTE

The AXBS master and slave configuration information can be read from MCM registers.

9.2 Introduction

The information found here provides information on the layout, configuration, and programming of the crossbar switch.

The crossbar switch connects bus masters and bus slaves using a crossbar switch structure. This structure allows up to four bus masters to access different bus slaves simultaneously, while providing arbitration among the bus masters when they access the same slave.

9.2.1 Features

The crossbar switch includes these features:

- Symmetric crossbar bus switch implementation
 - Allows concurrent accesses from different masters to different slaves

127

- Up to single-clock 32-bit transfer
- Programmable configuration for fixed-priority or round-robin slave port arbitration (see the chip-specific information).

9.3 Memory Map / Register Definition

This crossbar switch is designed for minimal gate count. It, therefore, has no memory-mapped configuration registers.

Please see the chip-specific information for information on whether the arbitration method in the crossbar switch is programmable, and by which module.

9.4 Functional Description

9.4.1 General operation

When a master accesses the crossbar switch, the access is immediately taken. If the targeted slave port of the access is available, then the access is immediately presented on the slave port. Single-clock or zero-wait-state accesses are possible through the crossbar. If the targeted slave port of the access is busy or parked on a different master port, the requesting master simply sees wait states inserted until the targeted slave port can service the master's request. The latency in servicing the request depends on each master's priority level and the responding slave's access time.

Because the crossbar switch appears to be just another slave to the master device, the master device has no knowledge of whether it actually owns the slave port it is targeting. While the master does not have control of the slave port it is targeting, it simply waits.

After the master has control of the slave port it is targeting, the master remains in control of the slave port until it relinquishes the slave port by running an IDLE cycle or by targeting a different slave port for its next access.

The master can also lose control of the slave port if another higher-priority master makes a request to the slave port.

The crossbar terminates all master IDLE transfers, as opposed to allowing the termination to come from one of the slave buses. Additionally, when no master is requesting access to a slave port, the crossbar drives IDLE transfers onto the slave bus, even though a default master may be granted access to the slave port.

Functional Description

When a slave bus is being idled by the crossbar, it remains parked with the last master to use the slave port. This is done to save the initial clock of arbitration delay that otherwise would be seen if the same master had to arbitrate to gain control of the slave port.

9.4.2 Arbitration

The crossbar switch supports two arbitration algorithms:

- Fixed priority
- Round-robin

The selection of the global slave port arbitration algorithm is described in the crossbar switch chip-specific information.

Arbitration during undefined length bursts 9.4.2.1

All lengths of burst accesses lock out arbitration until the last beat of the burst.

9.4.2.2 Fixed-priority operation

When operating in fixed-priority mode, each master is assigned a unique priority level with the highest numbered master having the highest priority (for example, in a system with 5 masters, master 1 has lower priority than master 3). If two masters request access to the same slave port, the master with the highest priority gains control over the slave port.

NOTE

In this arbitration mode, a higher-priority master can monopolize a slave port, preventing accesses from any lowerpriority master to the port.

When a master makes a request to a slave port, the slave port checks whether the new requesting master's priority level is higher than that of the master that currently has control over the slave port, unless the slave port is in a parked state. The slave port performs an arbitration check at every clock edge to ensure that the proper master, if any, has control of the slave port.

The following table describes possible scenarios based on the requesting master port:

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018 128 **NXP Semiconductors**

129

Table 9-1. How the Crossbar Switch grants control of a slave port to a master

When	Then the Crossbar Switch grants control to the requesting master
Both of the following are true: The current master is not running a transfer. The new requesting master's priority level is higher than that of the current master.	At the next clock edge
The requesting master's priority level is lower than the current master.	At the conclusion of one of the following cycles: • An IDLE cycle • A non-IDLE cycle to a location other than the current slave port

9.4.2.3 Round-robin priority operation

When operating in round-robin mode, each master is assigned a relative priority based on the master port number. This relative priority is compared to the master port number (ID) of the last master to perform a transfer on the slave bus. The highest priority requesting master becomes owner of the slave bus at the next transfer boundary. Priority is based on how far ahead the ID of the requesting master is to the ID of the last master.

After granted access to a slave port, a master may perform as many transfers as desired to that port until another master makes a request to the same slave port. The next master in line is granted access to the slave port at the next transfer boundary, or possibly on the next clock cycle if the current master has no pending access request.

As an example of arbitration in round-robin mode, assume the crossbar is implemented with master ports 0, 1, 4, and 5. If the last master of the slave port was master 1, and master 0, 4, and 5 make simultaneous requests, they are serviced in the order: 4 then 5 then 0.

The round-robin arbitration mode generally provides a more fair allocation of the available slave-port bandwidth (compared to fixed priority) as the fixed master priority does not affect the master selection.

9.5 Initialization/application information

No initialization is required for the crossbar switch. See the chip-specific crossbar switch information for the reset state of the arbitration scheme.

Initialization/application information

Chapter 10 Peripheral Bridge (AIPS-Lite)

10.1 Chip-specific information for this module

10.1.1 Instantiation Information

This device contains one peripheral bridge.

A generic block diagram of the processor core and platform for this class of microcontrollers is shown in the following figure. The AIPS (PBRIDGE) module's location is highlighted.

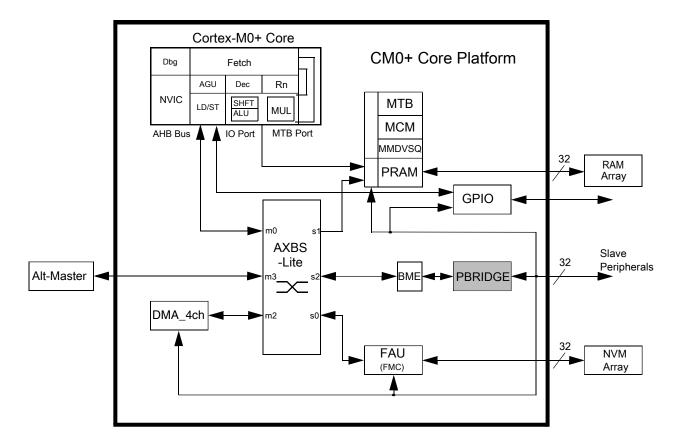


Figure 10-1. Cortex-M0+ core platform block diagram

10.1.1.1 Peripheral slot assignment

The peripheral bridge is used to access the registers of most of the modules on this device. See Peripheral Bridge (AIPS-Lite) Memory Map for the memory slot assignment.

10.2 Introduction

The peripheral bridge converts the crossbar switch interface to an interface that can access most of the slave peripherals on this chip.

The peripheral bridge occupies 64 MB of the address space, which is divided into peripheral slots of 4 KB. (It might be possible that all the peripheral slots are not used. See the memory map chapter for details on slot assignments.) The bridge includes separate clock enable inputs for each of the slots to accommodate slower peripherals.

10.2.1 Features

Key features of the peripheral bridge are:

• Supports peripheral slots with 8-, 16-, and 32-bit datapath width

10.2.2 General operation

The slave devices connected to the peripheral bridge are modules which contain a programming model of control and status registers. The system masters read and write these registers through the peripheral bridge.

The register maps of the peripherals are located on 4-KB boundaries. Each peripheral is allocated one or more 4-KB block(s) of the memory map. Two global external module enables are available for the remaining address space to allow for customization and expansion of addressed peripheral devices.

10.3 Memory map/register definition

The AIPS module(s) on this device do(es) not contain any user-programmable registers.

10.4 Functional description

The peripheral bridge functions as a bus protocol translator between the crossbar switch and the slave peripheral bus.

The peripheral bridge manages all transactions destined for the attached slave devices and generates select signals for modules on the peripheral bus by decoding accesses within the attached address space.

10.4.1 Access support

Aligned and misaligned 32-bit, 16-bit, and byte accesses are supported for 32-bit peripherals. Misaligned accesses are supported to allow memory to be placed on the slave peripheral bus. Peripheral registers must not be misaligned, although no explicit checking is performed by the peripheral bridge. All accesses are performed with a single transfer.

Functional description

All accesses to the peripheral slots must be sized less than or equal to the designated peripheral slot size. If an access is attempted that is larger than the targeted port, an error response is generated.

Chapter 11 Trigger MUX Control (TRGMUX)

11.1 Chip-specific information for this module

11.1.1 Module Interconnectivity

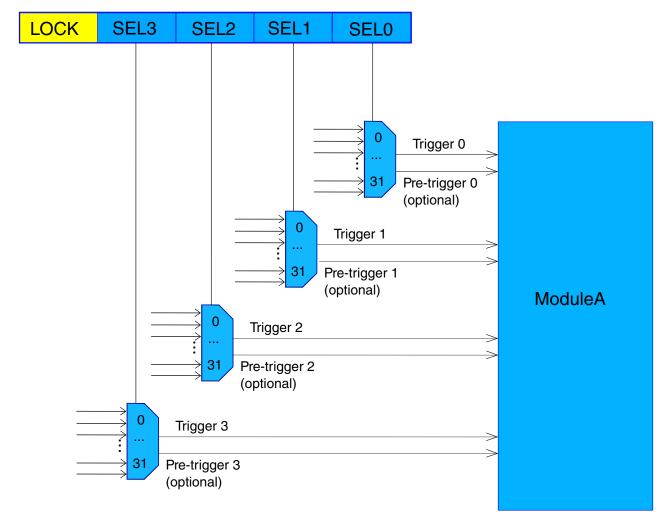
The module interconnectivity scheme is based on the TRGMUX. The TRGMUX introduces an extremely flexible methodology for connecting various trigger sources to multiple pins/peripherals. This TRGMUX design has removed some trigger inputs, and added one pre-stage trigger source TRGMUX1 for the TRGMUX0. TRGMUX1 supports up to 32 trigger sources and has 8 outputs. These 8 outputs will be the trigger inputs of TRGMUX0. TRGMUX0 supports up to 32 input sources, and its output will be the target modules.

With the TRGMUX, each peripheral which accepts external triggers will usually have one specific 32-bit trigger control register. Each control register supports up to 4 triggers, and each trigger can be selected from up to 32 inputs.

For some trigger sources, there is optional pre-trigger. The trigger and the pre-trigger are 1-1 paired up, and are both selected by the same trigger control register. Not every module has pre-trigger input, please refer to the respective module chapter for details.

Following is the main structure of TRGMUX, and take ModuleA as an example.

TRGMUX_ModuleA



NOTE

Each TRGMUX control register supports up to 4 trigger channels, but it's not necessary for each module to implement all of the 4 triggers. For those modules (e.g. external output, etc.) which needs more than 4 trigger inputs, multiple control registers are created to support that.

The trigger input and peripheral trigger control are assigned as the following figure indication.

Trigger source	Explanation
VSS	VSS trigger
VDD	VDD trigger
SIM_SW_TRG	Software trigger controlled by SIM module
TRGMUX_INx	TRGMUX external trigger input x
LPUARTx_RX_data	LPUARTx receive end of word trigger

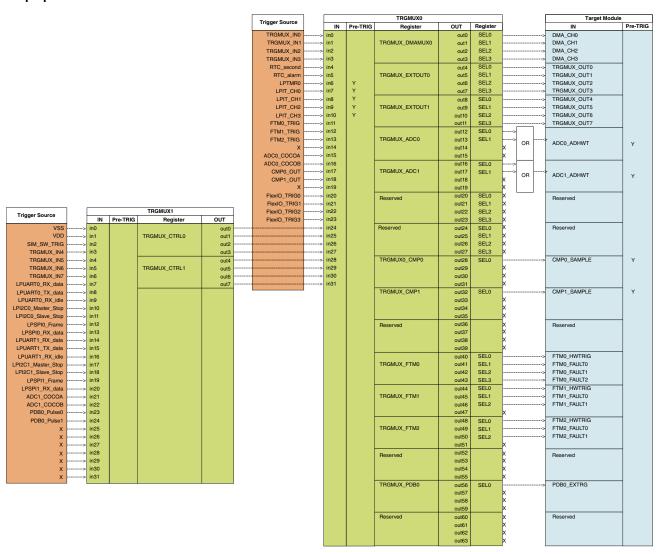
Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Chapter 11 Trigger MUX Control (TRGMUX)

LPUARTx_TX_data	LPUARTx transmit end of word trigger
LPUARTx_RX_idle	LPUARTx receive idle detected trigger
LPI2Cx_Master_Stop	LPI2Cx master stop or repeated start trigger
LPI2Cx_Slave_Stop	LPI2Cx slave stop or repeated start trigger
LPSPIx_Frame	LPSPIx end of frame trigger
LPSPIx_RX_data	LPSPIx receive data trigger
ADCx_COCOA	ADCx conversion complete trigger for data result A
ADCx_COCOB	ADCx conversion complete trigger for data result B
PDBx_Pulse0	PDBx pulse0 trigger
PDBx_Pulse1	PDBx pulse1 trigger
RTC_second	RTC second trigger
RTC_alarm	RTC alarm trigger
LPTMRx	LPTMRx timer counter match trigger
LPIT_CHx	LPIT channel x timer counter match trigger
FTMx_TRIG	FTMx timer counter match trigger
CMPx_OUT	CMPx output trigger
FlexIO_TRIGx	FlexIO timer x counter match trigger

Chip-specific information for this module



						[Trigger Source				TRGMUX0			1	Target Mo	dule
							(same as above)		IN	Pre-TRIG	Register	OUT	Register		IN	Pre-TR
							TRGMUX_IN0	>	in0		Reserved	out64	Ť	x	Reserved	
							TRGMUX_IN1	>	in1			out65		x		
							TRGMUX_IN2	>	in2			out66		x		
							TRGMUX_IN3	>	in3			out67		x		
							RTC_second	>	in4			out68	SEL0	;	FlexIO_TRG_TIM0	
							RTC_alarm	>	in5		TRGMUX_FLEXIO	out69	SEL1	;	FlexIO_TRG_TIM1	
							LPTMR0	>	in6	Y	THGMUX_FLEXIO	out70	SEL2	;	FlexIO_TRG_TIM2	
							LPIT_CH0	>	in7	Y		out71	SEL3	;	FlexIO_TRG_TIM3	
							LPIT_CH1	>	in8	Υ		out72	SEL0	;	LPIT_TRG_CH0	1
							LPIT_CH2	>	in9	Y	TDCMUV LDITO	out73	SEL1	;	LPIT_TRG_CH1	
							LPIT_CH3	>	in10	Y	TRGMUX_LPIT0	out74	SEL2	;	LPIT_TRG_CH2	
							FTM0_TRIG	>	in11			out75	SEL3		LPIT_TRG_CH3	
							FTM1_TRIG		in12			out76	SEL0		LPUARTO_TRG	+
							FTM2_TRIG		in13		TRGMUX_LPUART0	out77	OLLO	×	Li Granio_mid	
							X X		in14			out78		×		
							ADC0_COCOA		in15			out79		Ç		
							ADC0_COCOB		in16			out80		n .	LPUART1_TRG	+
							CMP0_OUT		in17		TRGMUX_LPUART1	out81	SEL0	x	S. OAIII _ ING	
							CMP0_OUT	>	in17			out82		Ç		
							_	>				out83		Ç		
							X TDIOS	>	in19				051.0	r	L DIOCO, TDC	-
							FlexIO_TRIG0	>	in20		TRGMUX_LPI2C0	out84	SEL0	,	LPI2C0_TRG	
						,	FlexIO_TRIG1	>	in21			out85		Ĉ		
rigger Source				TRGMUX1 (same as a			FlexIO_TRIG2	>	in22			out86		X.		
ame as above)		IN	Pre-TRIG	Register	OUT		FlexIO_TRIG3	>	in23			out87		X		4
VSS	>	in0			out0			>	in24		TRGMUX_LPI2C1	out88	SEL0	;	LPI2C1_TRG	
VDD	>	in1		TRGMUX_CTRL0	out1			>	in25			out89		X		
SIM_SW_TRIG	>	in2			out2			>	in26			out90		X		
TRGMUX_IN4	>	in3			out3			>	in27			out91		x		
TRGMUX_IN5	>	in4			out4			>	in28		TRGMUX_LPSPI0	out92	SEL0	;	LPSPI0_TRG	
TRGMUX_IN6	>	in5		TRGMUX_CTRL1	out5			>	in29		_	out93		x		
TRGMUX_IN7	>	in6			out6			>	in30			out94		x		
UART0_RX_data	>	in7			out7			>	in31			out95		x		
PUART0_TX_data		in8				1 1					TRGMUX_LPSPI1	out96	SEL0	;	LPSPI1_TRG	
PUARTO_RX_idle		in9										out97		x		
2C0_Master_Stop		in10										out98		x		
12C0_Slave_Stop		in11										out99		x		
LPSPI0_Frame		in12									TRGMUX_LPTMR0	out100	SEL0	;	LPTMR0_ALT0	1
LPSPI0_RX_data		in13									TTIGINOX_EL TIMITO	out101		x		
PUART1_RX_data		in14										out102		x		
PUART1_TX_data		in15										out103		x		
PUART1_RX_idle		in16									TRGMUX_TSI	out104	SEL0	;	TSI_HW_TRG	
2C1_Master_Stop		in17									THGMUX_15I	out105	OLLO	x		
		in18										out106		x		
2C1_Slave_Stop LPSPI1_Frame		in19										out107		x		
	>											out108	SEL0	;	PWT_IN0	+
LPSPI1_RX_data		in20									TRGMUX_PWT	out109		x		
ADC1_COCOA ADC1_COCOB	>	in21 in22										out110		x		
	>											out111		x		
PDB0_Pulse0	>	in23														_
PDB0_Pulse1	>	in24														
X	>	in25														
х	>	in26														
х	>	in27														
X	>	in28														
X	>	in29														
X	>	in30														
X	>	in31														
						.										

NOTE

When using the TRGMUX to trigger DMA, DMAMUX must be configured (in the DMAMUX_CHCFG register) with ENBL, TRIG bit set, meanwhile SOURCE bits must be !=0.

NOTE

For each ADC, the two triggers are OR'ed together to provide a flexible trigger scheme for the hardware trigger of each ADC, while the pre-triggers are not OR'ed. The LPIT pre-triggers can be pre-triggers for each ADC. There is another PDB pre-trigger scheme existing on this device, which is not through TRGMUX. Please refer to ADC section for details on ADC trigger implementation on this device.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

11.2 Introduction

The trigger MUX module (TRGMUX) allows software to configure the trigger inputs for various peripherals.

11.2.1 **Features**

The Trigger MUX module allows software to configure the trigger inputs for various peripherals.

Trigger MUX select

11.3 Functional description

The Trigger MUX module allows software to configure the trigger inputs for various peripherals.

Each peripheral has its own unique TRGMUX register that is used to select the trigger source for peripheral.

See each peripheral's TRGMUX register for details.

Memory map and register definition 11.4

The TRGMUX module contains register fields for selecting the trigger input for peripheral modules.

TRGMUX1 Register Descriptions

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018 140 NXP Semiconductors

11.4.1.1 TRGMUX1 Memory Map

Table 11-1. Select Bit Fields

Field	Function
5-0	This read/write bit field is used to configure the MUX select for the peripheral trigger inputs.
SEL	000000 - (0x00) Trigger function is disabled.
	000001 - (0x01) VDD is selected.
	000010 - (0x02) SIM Software trigger is selected.
	000011 - (0x03) TRGMUX_IN4 input is selected.
	000100 - (0x04) TRGMUX_IN5 input is selected.
	000101 - (0x05) TRGMUX_IN6 input is selected.
	000110 - (0x06) TRGMUX_IN7 input is selected.
	000111 - (0x07) LPUART0 RX Data is selected.
	001000 - (0x08) LPUART0 TX Data is selected.
	001001 - (0x09) LPUART0 RX Idle is selected.
	001010 - (0x0a) LPI2C0 Master STOP is selected.
	001011 - (0x0b) LPI2C0 Slave STOP is selected.
	001100 - (0x0c) LPSPI0 Frame is selected.
	001101 - (0x0d) LPSPI0 RX data is selected.
	001110 - (0x0e) LPUART1 RX Data is selected.
	001111 - (0x0f) LPUART1 TX Data is selected.
	010000 - (0x10) LPUART1 RX Idle is selected.
	010001 - (0x11) LPI2C1 Master STOP is selected.
	010010 - (0x12) LPI2C1 Slave STOP is selected.
	010011 - (0x13) LPSPI1 Frame is selected.
	010100 - (0x14) LPSPI1 RX data is selected.
	010101 - (0x15) ADC1_COCOA is selected.
	010110 - (0x16) ADC1_COCOB is selected.
	010111 - (0x17) PDB0_Pulse0 is selected.
	011000 - (0x18) PDB0_Pulse1 is selected.
	011001 - (0x19) Unused.
	011010 - (0x1a) Unused.
	011011 - (0x1b) Unused.
	011100 - (0x1c) Unused.
	011101 - (0x1d) Unused.
	011110 - (0x1e) Unused.
	011111 - (0x1f) Unused.
	100000 - (0x20) Unused
	100001 - (0x21) Unused
	100010 - (0x22) Unused
	100011 - (0x23) Unused

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Memory map and register definition

Table 11-1. Select Bit Fields

Field	Function
	100100 - (0x24) Unused
	100101 - (0x25) Unused
	100110 - (0x26) Unused
	100111 - (0x27) Unused
	101000 - (0x28) Unused
	101001 - (0x29) Unused
	101010 - (0x2a) Unused
	101011 - (0x2b) Unused
	101100 - (0x2c) Unused
	101101 - (0x2d) Unused
	101110 - (0x2e) Unused
	101111 - (0x2f) Unused
	110000 - (0x30) Unused
	110001 - (0x31) Unused
	110010 - (0x32) Unused
	110011 - (0x33) Unused
	110100 - (0x34) Unused
	110101 - (0x35) Unused
	110110 - (0x36) Unused
	110111 - (0x37) Unused
	111000 - (0x38) Unused
	111001 - (0x39) Unused
	111010 - (0x3a) Unused
	111011 - (0x3b) Unused
	111100 - (0x3c) Unused
	111101 - (0x3d) Unused
	111110 - (0x3e) Unused
	111111 - (0x3f) Unused

Absolute	Register	Width	Access	Reset value
address		(In bits)		
40063000h	TRGMUX_CTRL0 (TRGMUX_CTRL0)	32	RW	00000000h
40063004h	TRGMUX_CTRL1 (TRGMUX_CTRL1)	32	RW	00000000h

11.4.1.2 TRGMUX_CTRL0 (TRGMUX_CTRL0)

11.4.1.2.1 Address

Register	Offset
TRGMUX_CTRL0	40063000h

11.4.1.2.2 Function

TRGMUX Register

11.4.1.2.3 Diagram

Bits	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
R W	LK	Rese rved			SE	L3			Rese	erved			SE	L2		
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Bits	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
R W	Rese	erved	SEL1						Rese	erved	SEL0					
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

11.4.1.2.4 Fields

Field	Field Function			
31	Enable			
LK	This bit shows whether the register can be written or not.			
	Register can be written. Register cannot be written until the next system Reset.			
30	This read-only bit field is reserved and always has the value 0.			
_				
29-24	Trigger MUX Input 3 Source Select			
SEL3	This read/write bit field is used to configure the MUX select for peripheral trigger input 3. Refer to the Select Bit Fields table in the Features section for bit field information.			
23-22 —	This read-only bit field is reserved and always has the value 0.			
21-16	Trigger MUX Input 2 Source Select			
SEL2	This read/write bit field is used to configure the MUX select for peripheral trigger input 2. Refer to the Select Bit Fields table in the Features section for bit field information.			

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Memory map and register definition

Field	Function				
15-14	This read-only bit field is reserved and always has the value 0.				
_					
13-8	Trigger MUX Input 1 Source Select				
SEL1	This read/write bit field is used to configure the MUX select for peripheral trigger input 1. Refer to the Select Bit Fields table in the Features section for bit field information.				
7-6	This read-only bit field is reserved and always has the value 0.				
_					
5-0	Trigger MUX Input 0 Source Select				
SEL0	This read/write bit field is used to configure the MUX select for peripheral trigger input 0. Refer to the Select Bit Fields table in the Features section for bit field information.				

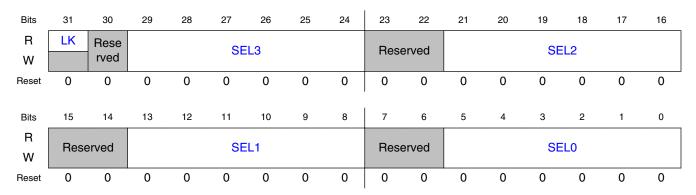
11.4.1.3 TRGMUX_CTRL1 (TRGMUX_CTRL1)

11.4.1.3.1 Address

Register	Offset					
TRGMUX_CTRL1	40063004h					

TRGMUX Register

11.4.1.3.2 Diagram



11.4.1.3.3 Fields

Field	Function
31	Enable
LK	This bit shows whether the register can be written or not.

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Field	Function
	0 - Register can be written.
	1 - Register cannot be written until the next system Reset.
30	This read-only bit field is reserved and always has the value 0.
_	
29-24	Trigger MUX Input 3 Source Select
SEL3	This read/write bit field is used to configure the MUX select for peripheral trigger input 3. Refer to the Select Bit Fields table in the Features section for bit field information.
23-22	This read-only bit field is reserved and always has the value 0.
_	
21-16	Trigger MUX Input 2 Source Select
SEL2	This read/write bit field is used to configure the MUX select for peripheral trigger input 2. Refer to the Select Bit Fields table in the Features section for bit field information.
15-14	This read-only bit field is reserved and always has the value 0.
_	
13-8	Trigger MUX Input 1 Source Select
SEL1	This read/write bit field is used to configure the MUX select for peripheral trigger input 1. Refer to the Select Bit Fields table in the Features section for bit field information.
7-6	This read-only bit field is reserved and always has the value 0.
_	
5-0	Trigger MUX Input 0 Source Select
SEL0	This read/write bit field is used to configure the MUX select for peripheral trigger input 0. Refer to the Select Bit Fields table in the Features section for bit field information.

11.4.2 TRGMUX0 Register Descriptions

11.4.2.1 TRGMUX0 Memory Map

Table 11-2. Select Bit Fields

Field	Function
5-0	This read/write bit field is used to configure the MUX select for the peripheral trigger inputs.
SEL	000000 - (0x00) TRGMUX IN0 input is selected.
	000001 - (0x01) TRGMUX IN1 input is selected.
	000010 - (0x02) TRGMUX IN2 input is selected.
	000011 - (0x03) TRGMUX IN3 input is selected.
	000100 - (0x04) RTC Seconds input is selected.
	000101 - (0x05) RTC Alarm input is selected.
	000110 - (0x06) LPTMR0 input is selected.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Table 11-2. Select Bit Fields

Field	Function
	000111 - (0x07) LPIT CH0 input is selected.
	001000 - (0x08) LPIT CH1 input is selected.
	001001 - (0x09) LPIT CH2 input is selected.
	001010 - (0x0a) LPIT CH3 input is selected.
	001011 - (0x0b) FTM0 Trigger is selected.
	001100 - (0x0c) FTM1 Trigger is selected.
	001101 - (0x0d) FTM2 Trigger is selected.
	001110 - (0x0e) Unused.
	001111 - (0x0f) ADC0 COCOA is selected.
	010000 - (0x10) ADC0 COCOB is selected.
	010001 - (0x11) CMP0 Output is selected.
	010010 - (0x12) CMP1 Output is selected.
	010011 - (0x13) Unused.
	010100 - (0x14) FLEXIO Trigger 0 is selected.
	010101 - (0x15) FLEXIO Trigger 1 is selected.
	010110 - (0x16) FLEXIO Trigger 2 is selected.
	010111 - (0x17) FLEXIO Trigger 3 is selected.
	011000 - (0x18) TRGMUX1 Output 0 selected.
	011001 - (0x19) TRGMUX1 Output 1 is selected.
	011010 - (0x1a) TRGMUX1 Output 2 is selected.
	011011 - (0x1b) TRGMUX1 Output 3 is selected.
	011100 - (0x1c) TRGMUX1 Output 4 is selected.
	011101 - (0x1d) TRGMUX1 Output 5 is selected.
	011110 - (0x1e) TRGMUX1 Output 6 is selected.
	011111 - (0x1f) TRGMUX1 Output 7 is selected.
	100000 - (0x20) Unused
	100001 - (0x21) Unused
	100010 - (0x22) Unused
	100011 - (0x23) Unused
	100100 - (0x24) Unused
	100101 - (0x25) Unused
	100110 - (0x26) Unused
	100111 - (0x27) Unused
	101000 - (0x28) Unused
	101001 - (0x29) Unused
	101010 - (0x2a) Unused
	101011 - (0x2b) Unused
	101100 - (0x2c) Unused

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Table 11-2. Select Bit Fields

Field	Function
	101101 - (0x2d) Unused
	101110 - (0x2e) Unused
	101111 - (0x2f) Unused
	110000 - (0x30) Unused
	110001 - (0x31) Unused
	110010 - (0x32) Unused
	110011 - (0x33) Unused
	110100 - (0x34) Unused
	110101 - (0x35) Unused
	110110 - (0x36) Unused
	110111 - (0x37) Unused
	111000 - (0x38) Unused
	111001 - (0x39) Unused
	111010 - (0x3a) Unused
	111011 - (0x3b) Unused
	111100 - (0x3c) Unused
	111101 - (0x3d) Unused
	111110 - (0x3e) Unused
	111111 - (0x3f) Unused

Absolute	Register	Width	Access	Reset value
address		(In bits)		
40062000h	TRGMUX DMAMUX0 (TRGMUX_DMAMUX0)	32	RW	00000000h
40062004h	TRGMUX EXTOUT0 (TRGMUX_EXTOUT0)	32	RW	00000000h
40062008h	TRGMUX EXTOUT1 (TRGMUX_EXTOUT1)	32	RW	00000000h
4006200Ch	TRGMUX ADC0 (TRGMUX_ADC0)	32	RW	00000000h
40062010h	TRGMUX ADC1 (TRGMUX_ADC1)	32	RW	00000000h
4006201Ch	TRGMUX CMP0 (TRGMUX_CMP0)	32	RW	00000000h
40062020h	TRGMUX CMP1 (TRGMUX_CMP1)	32	RW	00000000h
40062028h	TRGMUX FTM0 (TRGMUX_FTM0)	32	RW	00000000h
4006202Ch	TRGMUX FTM1 (TRGMUX_FTM1)	32	RW	00000000h
40062030h	TRGMUX FTM2 (TRGMUX_FTM2)	32	RW	00000000h
40062038h	TRGMUX PDB0 (TRGMUX_PDB0)	32	RW	00000000h
40062044h	TRGMUX FLEXIO (TRGMUX_FLEXIO)	32	RW	00000000h
40062048h	TRGMUX LPIT0 (TRGMUX_LPIT0)	32	RW	00000000h
4006204Ch	TRGMUX LPUART0 (TRGMUX_LPUART0)	32	RW	00000000h
40062050h	TRGMUX LPUART1 (TRGMUX_LPUART1)	32	RW	00000000h

Table continues on the next page...

Absolute	Register	Width	Access	Reset value
address		(In bits)		
40062054h	TRGMUX LPI2C0 (TRGMUX_LPI2C0)	32	RW	00000000h
40062058h	TRGMUX LPI2C1 (TRGMUX_LPI2C1)	32	RW	00000000h
4006205Ch	TRGMUX LPSPI0 (TRGMUX_LPSPI0)	32	RW	00000000h
40062060h	TRGMUX LPSPI1 (TRGMUX_LPSPI1)	32	RW	00000000h
40062064h	TRGMUX LPTMR0 (TRGMUX_LPTMR0)	32	RW	00000000h
40062068h	TRGMUX TSI (TRGMUX_TSI)	32	RW	00000000h
4006206Ch	TRGMUX PWT (TRGMUX_PWT)	32	RW	00000000h

11.4.2.2 TRGMUX DMAMUX0 (TRGMUX_DMAMUX0)

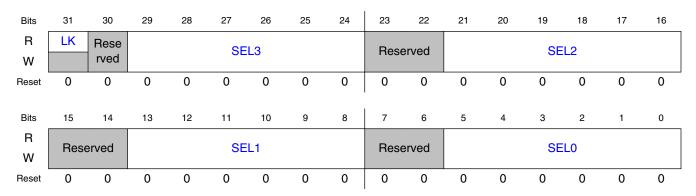
11.4.2.2.1 Address

Register	Offset
TRGMUX_DMAMUX0	40062000h

11.4.2.2.2 Function

TRGMUX Register

11.4.2.2.3 Diagram



11.4.2.2.4 Fields

	Field	Function
Γ	31	Enable

Table continues on the next page...

Field	Function
LK	This bit shows whether the register can be written or not.
	Register can be written. Register cannot be written until the next system Reset.
30	This read-only bit field is reserved and always has the value 0.
_	
29-24	Trigger MUX Input 3 Source Select
SEL3	This read/write bit field is used to configure the MUX select for peripheral trigger input 3. Refer to the Select Bit Fields table in the Features section for bit field information.
23-22	This read-only bit field is reserved and always has the value 0.
_	
21-16	Trigger MUX Input 2 Source Select
SEL2	This read/write bit field is used to configure the MUX select for peripheral trigger input 2. Refer to the Select Bit Fields table in the Features section for bit field information.
15-14	This read-only bit field is reserved and always has the value 0.
_	
13-8	Trigger MUX Input 1 Source Select
SEL1	This read/write bit field is used to configure the MUX select for peripheral trigger input 1. Refer to the Select Bit Fields table in the Features section for bit field information.
7-6	This read-only bit field is reserved and always has the value 0.
_	
5-0	Trigger MUX Input 0 Source Select
SEL0	This read/write bit field is used to configure the MUX select for peripheral trigger input 0. Refer to the Select Bit Fields table in the Features section for bit field information.

11.4.2.3 TRGMUX EXTOUT0 (TRGMUX_EXTOUT0)

11.4.2.3.1 Address

Register	Offset
TRGMUX_EXTOUT0	40062004h

TRGMUX Register

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018 149 **NXP Semiconductors**

11.4.2.3.2 Diagram

Bits	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
R	LK	Rese			SE	£L3			Rese	erved			SE	L2		
W		iveu														
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
									ı							
Bits	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
R	_								_							
W	Reserved				SE	L1			Rese	erved			SE	L0		
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

11.4.2.3.3 Fields

Field	Function
31	Enable
LK	This bit shows whether the register can be written or not.
	O - Register can be written. 1 - Register cannot be written until the next system Reset.
30	This read-only bit field is reserved and always has the value 0.
_	
29-24	Trigger MUX Input 3 Source Select
SEL3	This read/write bit field is used to configure the MUX select for peripheral trigger input 3. Refer to the Select Bit Fields table in the Features section for bit field information.
23-22	This read-only bit field is reserved and always has the value 0.
_	
21-16	Trigger MUX Input 2 Source Select
SEL2	This read/write bit field is used to configure the MUX select for peripheral trigger input 2. Refer to the Select Bit Fields table in the Features section for bit field information.
15-14	This read-only bit field is reserved and always has the value 0.
_	
13-8	Trigger MUX Input 1 Source Select
SEL1	This read/write bit field is used to configure the MUX select for peripheral trigger input 1. Refer to the Select Bit Fields table in the Features section for bit field information.
7-6	This read-only bit field is reserved and always has the value 0.
_	
5-0	Trigger MUX Input 0 Source Select
SEL0	This read/write bit field is used to configure the MUX select for peripheral trigger input 0. Refer to the Select Bit Fields table in the Features section for bit field information.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018 150 **NXP Semiconductors**

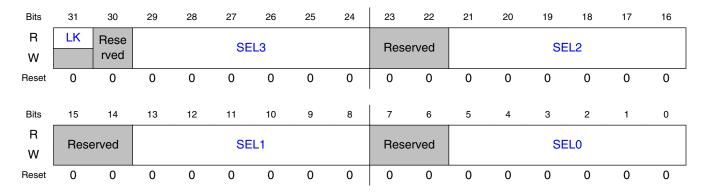
11.4.2.4 TRGMUX EXTOUT1 (TRGMUX_EXTOUT1)

11.4.2.4.1 Address

Register	Offset
TRGMUX_EXTOUT1	40062008h

TRGMUX Register

11.4.2.4.2 Diagram



11.4.2.4.3 Fields

Field	Function
31	Enable
LK	This bit shows whether the register can be written or not.
	0 - Register can be written. 1 - Register cannot be written until the next system Reset.
30	This read-only bit field is reserved and always has the value 0.
_	
29-24	Trigger MUX Input 3 Source Select
SEL3	This read/write bit field is used to configure the MUX select for peripheral trigger input 3. Refer to the Select Bit Fields table in the Features section for bit field information.
23-22	This read-only bit field is reserved and always has the value 0.
_	
21-16	Trigger MUX Input 2 Source Select
SEL2	This read/write bit field is used to configure the MUX select for peripheral trigger input 2. Refer to the Select Bit Fields table in the Features section for bit field information.
15-14	This read-only bit field is reserved and always has the value 0.
_	

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Field	Function
13-8	Trigger MUX Input 1 Source Select
SEL1	This read/write bit field is used to configure the MUX select for peripheral trigger input 1. Refer to the Select Bit Fields table in the Features section for bit field information.
7-6	This read-only bit field is reserved and always has the value 0.
_	
5-0	Trigger MUX Input 0 Source Select
SEL0	This read/write bit field is used to configure the MUX select for peripheral trigger input 0. Refer to the Select Bit Fields table in the Features section for bit field information.

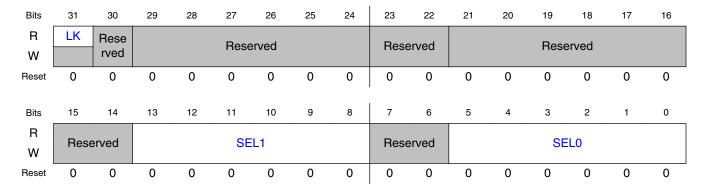
11.4.2.5 TRGMUX ADC0 (TRGMUX_ADC0)

11.4.2.5.1 Address

Register	Offset	
TRGMUX_ADC0	4006200Ch	

TRGMUX Register

11.4.2.5.2 Diagram



11.4.2.5.3 Fields

Field	Function
31	Enable
LK	This bit shows whether the register can be written or not.
	0 - Register can be written.

Table continues on the next page...

Field	Function
	1 - Register cannot be written until the next system Reset.
30	This read-only bit field is reserved and always has the value 0.
_	
29-24	This read-only bit field is reserved and always has the value 0.
_	
23-22	This read-only bit field is reserved and always has the value 0.
_	
21-16	This read-only bit field is reserved and always has the value 0.
_	
15-14	This read-only bit field is reserved and always has the value 0.
_	
13-8	Trigger MUX Input 1 Source Select
SEL1	This read/write bit field is used to configure the MUX select for peripheral trigger input 1. Refer to the Select Bit Fields table in the Features section for bit field information.
7-6	This read-only bit field is reserved and always has the value 0.
_	
5-0	Trigger MUX Input 0 Source Select
SEL0	This read/write bit field is used to configure the MUX select for peripheral trigger input 0. Refer to the Select Bit Fields table in the Features section for bit field information.

11.4.2.6 TRGMUX ADC1 (TRGMUX_ADC1)

11.4.2.6.1 Address

Register	Offset
TRGMUX_ADC1	40062010h

TRGMUX Register

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018 **NXP Semiconductors** 153

11.4.2.6.2 Diagram

Bits	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
R	LK	Rese			Poor	erved			Poor	erved			Poor	erved		
W		rved			nese	erveu			nese	erveu			nese	erveu		
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Bits	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
R	Daa	al			C.	1.4			Dane				CF	1.0		
W	Hese	erved			SE	LI			Hese	erved			5E	LO		
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

11.4.2.6.3 Fields

Field	Function
31	Enable
LK	This bit shows whether the register can be written or not.
	Register can be written. Register cannot be written until the next system Reset.
30	This read-only bit field is reserved and always has the value 0.
_	
29-24	This read-only bit field is reserved and always has the value 0.
_	
23-22	This read-only bit field is reserved and always has the value 0.
_	
21-16	This read-only bit field is reserved and always has the value 0.
_	
15-14	This read-only bit field is reserved and always has the value 0.
_	
13-8	Trigger MUX Input 1 Source Select
SEL1	This read/write bit field is used to configure the MUX select for peripheral trigger input 1. Refer to the Select Bit Fields table in the Features section for bit field information.
7-6	This read-only bit field is reserved and always has the value 0.
_	
5-0	Trigger MUX Input 0 Source Select
SEL0	This read/write bit field is used to configure the MUX select for peripheral trigger input 0. Refer to the Select Bit Fields table in the Features section for bit field information.

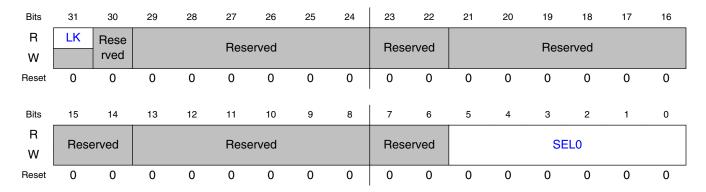
11.4.2.7 TRGMUX CMP0 (TRGMUX_CMP0)

11.4.2.7.1 Address

Register	Offset		
TRGMUX_CMP0	4006201Ch		

TRGMUX Register

11.4.2.7.2 Diagram



11.4.2.7.3 Fields

Field	Function
31	Enable
LK	This bit shows whether the register can be written or not.
	0 - Register can be written. 1 - Register cannot be written until the next system Reset.
30	This read-only bit field is reserved and always has the value 0.
_	
29-24	This read-only bit field is reserved and always has the value 0.
_	
23-22	This read-only bit field is reserved and always has the value 0.
_	
21-16	This read-only bit field is reserved and always has the value 0.
_	
15-14	This read-only bit field is reserved and always has the value 0.
_	
13-8	This read-only bit field is reserved and always has the value 0.

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Field	Function
_	
7-6	This read-only bit field is reserved and always has the value 0.
_	
5-0	Trigger MUX Input 0 Source Select
SEL0	This read/write bit field is used to configure the MUX select for peripheral trigger input 0. Refer to the Select Bit Fields table in the Features section for bit field information.

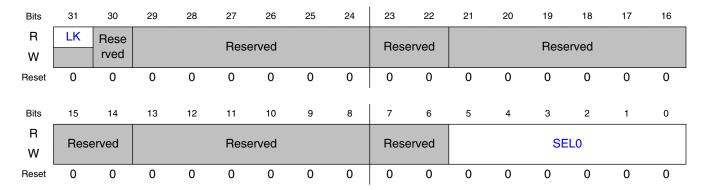
11.4.2.8 TRGMUX CMP1 (TRGMUX_CMP1)

11.4.2.8.1 Address

Register	Offset
TRGMUX_CMP1	40062020h

TRGMUX Register

11.4.2.8.2 Diagram



11.4.2.8.3 Fields

Field	Function
31	Enable
LK	This bit shows whether the register can be written or not.
	0 - Register can be written. 1 - Register cannot be written until the next system Reset.
30	This read-only bit field is reserved and always has the value 0.

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Field	Function
_	
29-24	This read-only bit field is reserved and always has the value 0.
_	
23-22	This read-only bit field is reserved and always has the value 0.
_	
21-16	This read-only bit field is reserved and always has the value 0.
_	
15-14	This read-only bit field is reserved and always has the value 0.
_	
13-8	This read-only bit field is reserved and always has the value 0.
_	
7-6	This read-only bit field is reserved and always has the value 0.
_	
5-0	Trigger MUX Input 0 Source Select
SEL0	This read/write bit field is used to configure the MUX select for peripheral trigger input 0. Refer to the Select Bit Fields table in the Features section for bit field information.

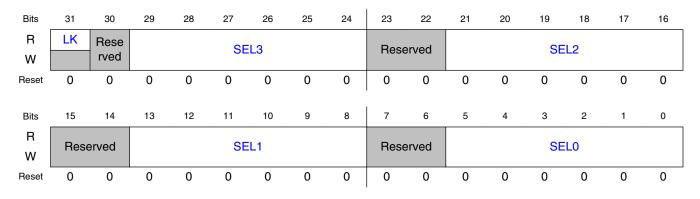
11.4.2.9 TRGMUX FTM0 (TRGMUX_FTM0)

11.4.2.9.1 Address

Register	Offset
TRGMUX_FTM0	40062028h

TRGMUX Register

11.4.2.9.2 Diagram



Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

11.4.2.9.3 Fields

Field	Function
31	Enable
LK	This bit shows whether the register can be written or not.
	Register can be written. Register cannot be written until the next system Reset.
30	This read-only bit field is reserved and always has the value 0.
_	
29-24	Trigger MUX Input 3 Source Select
SEL3	This read/write bit field is used to configure the MUX select for peripheral trigger input 3. Refer to the Select Bit Fields table in the Features section for bit field information.
23-22	This read-only bit field is reserved and always has the value 0.
_	
21-16	Trigger MUX Input 2 Source Select
SEL2	This read/write bit field is used to configure the MUX select for peripheral trigger input 2. Refer to the Select Bit Fields table in the Features section for bit field information.
15-14	This read-only bit field is reserved and always has the value 0.
_	
13-8	Trigger MUX Input 1 Source Select
SEL1	This read/write bit field is used to configure the MUX select for peripheral trigger input 1. Refer to the Select Bit Fields table in the Features section for bit field information.
7-6	This read-only bit field is reserved and always has the value 0.
_	
5-0	Trigger MUX Input 0 Source Select
SEL0	This read/write bit field is used to configure the MUX select for peripheral trigger input 0. Refer to the Select Bit Fields table in the Features section for bit field information.

11.4.2.10 TRGMUX FTM1 (TRGMUX_FTM1)

11.4.2.10.1 Address

Register	Offset
TRGMUX_FTM1	4006202Ch

TRGMUX Register

11.4.2.10.2 Diagram

Bits	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
R	LK	Rese			Door	n rod			Door	an to d			C.F.	1.0		
W		rved			nese	erved			nese	erved			30	L2		
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Bits	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
R	D				0.5	1.4			D				0.5	1.0		
W	Reserved		Reserved SEL1		Hese	erved			SE	L0						
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

11.4.2.10.3 Fields

Field	Function
31	Enable
LK	This bit shows whether the register can be written or not.
	Register can be written. Register cannot be written until the next system Reset.
30	This read-only bit field is reserved and always has the value 0.
_	
29-24	This read-only bit field is reserved and always has the value 0.
_	
23-22	This read-only bit field is reserved and always has the value 0.
_	
21-16	Trigger MUX Input 2 Source Select
SEL2	This read/write bit field is used to configure the MUX select for peripheral trigger input 2. Refer to the Select Bit Fields table in the Features section for bit field information.
15-14	This read-only bit field is reserved and always has the value 0.
_	
13-8	Trigger MUX Input 1 Source Select
SEL1	This read/write bit field is used to configure the MUX select for peripheral trigger input 1. Refer to the Select Bit Fields table in the Features section for bit field information.
7-6	This read-only bit field is reserved and always has the value 0.
_	
5-0	Trigger MUX Input 0 Source Select
SEL0	This read/write bit field is used to configure the MUX select for peripheral trigger input 0. Refer to the Select Bit Fields table in the Features section for bit field information.

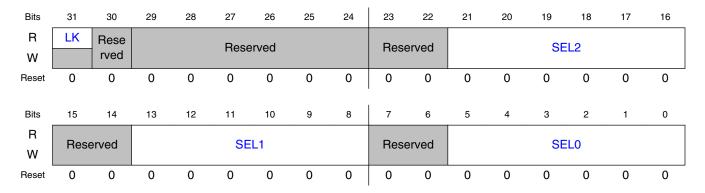
TRGMUX FTM2 (TRGMUX_FTM2) 11.4.2.11

11.4.2.11.1 **Address**

Register	Offset
TRGMUX_FTM2	40062030h

TRGMUX Register

11.4.2.11.2 Diagram



11.4.2.11.3 Fields

Field	Function
31	Enable
LK	This bit shows whether the register can be written or not.
	0 - Register can be written. 1 - Register cannot be written until the next system Reset.
30	This read-only bit field is reserved and always has the value 0.
_	
29-24	This read-only bit field is reserved and always has the value 0.
_	
23-22	This read-only bit field is reserved and always has the value 0.
_	
21-16	Trigger MUX Input 2 Source Select
SEL2	This read/write bit field is used to configure the MUX select for peripheral trigger input 2. Refer to the Select Bit Fields table in the Features section for bit field information.
15-14	This read-only bit field is reserved and always has the value 0.
_	

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018 160 **NXP Semiconductors**

Field	Function
13-8	Trigger MUX Input 1 Source Select
SEL1	This read/write bit field is used to configure the MUX select for peripheral trigger input 1. Refer to the Select Bit Fields table in the Features section for bit field information.
7-6	This read-only bit field is reserved and always has the value 0.
_	
5-0	Trigger MUX Input 0 Source Select
SEL0	This read/write bit field is used to configure the MUX select for peripheral trigger input 0. Refer to the Select Bit Fields table in the Features section for bit field information.

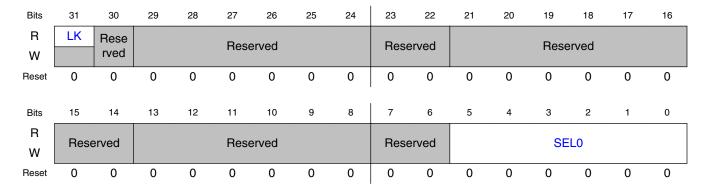
11.4.2.12 TRGMUX PDB0 (TRGMUX_PDB0)

11.4.2.12.1 Address

Register	Offset
TRGMUX_PDB0	40062038h

TRGMUX Register

11.4.2.12.2 Diagram



11.4.2.12.3 Fields

Field	Function
31	Enable
LK	This bit shows whether the register can be written or not.
	0 - Register can be written.

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Field	Function
	1 - Register cannot be written until the next system Reset.
30	This read-only bit field is reserved and always has the value 0.
_	
29-24	This read-only bit field is reserved and always has the value 0.
_	
23-22	This read-only bit field is reserved and always has the value 0.
_	
21-16	This read-only bit field is reserved and always has the value 0.
_	
15-14	This read-only bit field is reserved and always has the value 0.
_	
13-8	This read-only bit field is reserved and always has the value 0.
_	
7-6	This read-only bit field is reserved and always has the value 0.
_	
5-0	Trigger MUX Input 0 Source Select
SEL0	This read/write bit field is used to configure the MUX select for peripheral trigger input 0. Refer to the Select Bit Fields table in the Features section for bit field information.

11.4.2.13 TRGMUX FLEXIO (TRGMUX_FLEXIO)

11.4.2.13.1 Address

Register	Offset
TRGMUX_FLEXIO	40062044h

TRGMUX Register

11.4.2.13.2 Diagram

Bits	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
R	LK	Rese			O.E.	1.0			Poor	erved			QE.	L2		
W		rved		SEL3					nese	erveu			36	LZ		
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Bits	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
R	Daa	al			C.F.	1.4			Dan				C.			
W	Reserved		Reserved SEL1				Rese	erved			SE	L0				
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

11.4.2.13.3 Fields

Field	Function
31	Enable
LK	This bit shows whether the register can be written or not.
	O - Register can be written. 1 - Register cannot be written until the next system Reset.
30	This read-only bit field is reserved and always has the value 0.
_	
29-24	Trigger MUX Input 3 Source Select
SEL3	This read/write bit field is used to configure the MUX select for peripheral trigger input 3. Refer to the Select Bit Fields table in the Features section for bit field information.
23-22	This read-only bit field is reserved and always has the value 0.
_	
21-16	Trigger MUX Input 2 Source Select
SEL2	This read/write bit field is used to configure the MUX select for peripheral trigger input 2. Refer to the Select Bit Fields table in the Features section for bit field information.
15-14	This read-only bit field is reserved and always has the value 0.
_	
13-8	Trigger MUX Input 1 Source Select
SEL1	This read/write bit field is used to configure the MUX select for peripheral trigger input 1. Refer to the Select Bit Fields table in the Features section for bit field information.
7-6	This read-only bit field is reserved and always has the value 0.
_	
5-0	Trigger MUX Input 0 Source Select
SEL0	This read/write bit field is used to configure the MUX select for peripheral trigger input 0. Refer to the Select Bit Fields table in the Features section for bit field information.

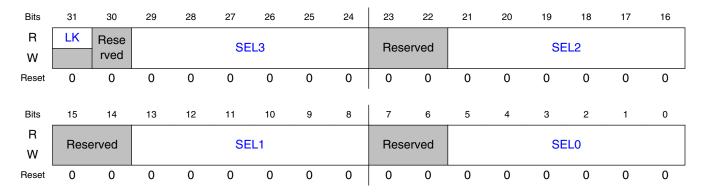
11.4.2.14 TRGMUX LPIT0 (TRGMUX_LPIT0)

11.4.2.14.1 Address

Register	Offset
TRGMUX_LPIT0	40062048h

TRGMUX Register

11.4.2.14.2 Diagram



11.4.2.14.3 Fields

Field	Function
31	Enable
LK	This bit shows whether the register can be written or not.
	0 - Register can be written. 1 - Register cannot be written until the next system Reset.
30	This read-only bit field is reserved and always has the value 0.
_	
29-24	Trigger MUX Input 3 Source Select
SEL3	This read/write bit field is used to configure the MUX select for peripheral trigger input 3. Refer to the Select Bit Fields table in the Features section for bit field information.
23-22	This read-only bit field is reserved and always has the value 0.
_	
21-16	Trigger MUX Input 2 Source Select
SEL2	This read/write bit field is used to configure the MUX select for peripheral trigger input 2. Refer to the Select Bit Fields table in the Features section for bit field information.
15-14	This read-only bit field is reserved and always has the value 0.
_	

Table continues on the next page...

Field	Function
13-8	Trigger MUX Input 1 Source Select
SEL1	This read/write bit field is used to configure the MUX select for peripheral trigger input 1. Refer to the Select Bit Fields table in the Features section for bit field information.
7-6	This read-only bit field is reserved and always has the value 0.
_	
5-0	Trigger MUX Input 0 Source Select
SEL0	This read/write bit field is used to configure the MUX select for peripheral trigger input 0. Refer to the Select Bit Fields table in the Features section for bit field information.

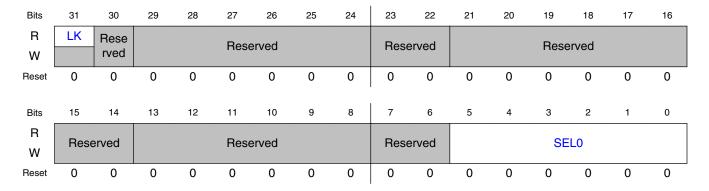
11.4.2.15 TRGMUX LPUARTO (TRGMUX_LPUARTO)

11.4.2.15.1 Address

Register	Offset
TRGMUX_LPUART0	4006204Ch

TRGMUX Register

11.4.2.15.2 Diagram



11.4.2.15.3 Fields

Field	Function
31	Enable
LK	This bit shows whether the register can be written or not.
	0 - Register can be written.

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Field	Function
	1 - Register cannot be written until the next system Reset.
30	This read-only bit field is reserved and always has the value 0.
_	
29-24	This read-only bit field is reserved and always has the value 0.
_	
23-22	This read-only bit field is reserved and always has the value 0.
_	
21-16	This read-only bit field is reserved and always has the value 0.
_	
15-14	This read-only bit field is reserved and always has the value 0.
_	
13-8	This read-only bit field is reserved and always has the value 0.
_	
7-6	This read-only bit field is reserved and always has the value 0.
_	
5-0	Trigger MUX Input 0 Source Select
SEL0	This read/write bit field is used to configure the MUX select for peripheral trigger input 0. Refer to the Select Bit Fields table in the Features section for bit field information.

11.4.2.16 TRGMUX LPUART1 (TRGMUX_LPUART1)

11.4.2.16.1 Address

Register	Offset
TRGMUX_LPUART1	40062050h

TRGMUX Register

11.4.2.16.2 Diagram

Bits	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
R	LK	Rese			Poor	arvod			Poor	nuod			Poor	nuod		
W		rved		Reserved						Reserved Reserved						
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Bits	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
R	Daa	al			Dane				Dane				CF			
W	Reserved				Hese	erved			Hese	erved			5E	L0		
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

11.4.2.16.3 Fields

Field	Function
31	Enable
LK	This bit shows whether the register can be written or not.
	Register can be written. Register cannot be written until the next system Reset.
30	This read-only bit field is reserved and always has the value 0.
_	
29-24	This read-only bit field is reserved and always has the value 0.
_	
23-22	This read-only bit field is reserved and always has the value 0.
_	
21-16	This read-only bit field is reserved and always has the value 0.
_	
15-14	This read-only bit field is reserved and always has the value 0.
_	
13-8	This read-only bit field is reserved and always has the value 0.
_	
7-6	This read-only bit field is reserved and always has the value 0.
_	
5-0	Trigger MUX Input 0 Source Select
SEL0	This read/write bit field is used to configure the MUX select for peripheral trigger input 0. Refer to the Select Bit Fields table in the Features section for bit field information.

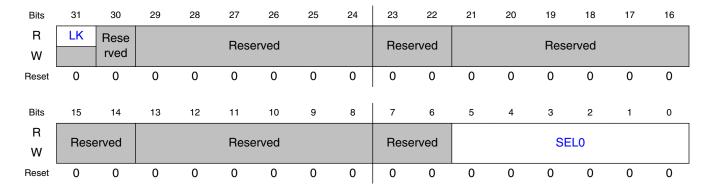
11.4.2.17 TRGMUX LPI2C0 (TRGMUX_LPI2C0)

11.4.2.17.1 Address

Register	Offset
TRGMUX_LPI2C0	40062054h

TRGMUX Register

11.4.2.17.2 Diagram



11.4.2.17.3 Fields

Field	Function
31	Enable
LK	This bit shows whether the register can be written or not.
	Register can be written. Register cannot be written until the next system Reset.
30	This read-only bit field is reserved and always has the value 0.
_	
29-24	This read-only bit field is reserved and always has the value 0.
_	
23-22	This read-only bit field is reserved and always has the value 0.
_	
21-16	This read-only bit field is reserved and always has the value 0.
_	
15-14	This read-only bit field is reserved and always has the value 0.
_	
13-8	This read-only bit field is reserved and always has the value 0.
_	
7-6	This read-only bit field is reserved and always has the value 0.

Table continues on the next page...

Field	Function
5-0	Trigger MUX Input 0 Source Select
SEL0	This read/write bit field is used to configure the MUX select for peripheral trigger input 0. Refer to the Select Bit Fields table in the Features section for bit field information.

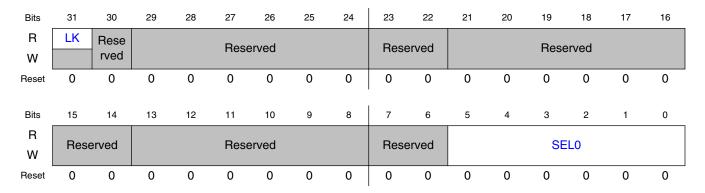
11.4.2.18 TRGMUX LPI2C1 (TRGMUX_LPI2C1)

11.4.2.18.1 Address

Register	Offset
TRGMUX_LPI2C1	40062058h

TRGMUX Register

11.4.2.18.2 Diagram



11.4.2.18.3 Fields

Field	Function
31	Enable
LK	This bit shows whether the register can be written or not.
	0 - Register can be written. 1 - Register cannot be written until the next system Reset.
30	This read-only bit field is reserved and always has the value 0.
_	
29-24	This read-only bit field is reserved and always has the value 0.
_	

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Field	Function
23-22	This read-only bit field is reserved and always has the value 0.
_	
21-16	This read-only bit field is reserved and always has the value 0.
_	
15-14	This read-only bit field is reserved and always has the value 0.
_	
13-8	This read-only bit field is reserved and always has the value 0.
_	
7-6	This read-only bit field is reserved and always has the value 0.
_	
5-0	Trigger MUX Input 0 Source Select
SEL0	This read/write bit field is used to configure the MUX select for peripheral trigger input 0. Refer to the Select Bit Fields table in the Features section for bit field information.

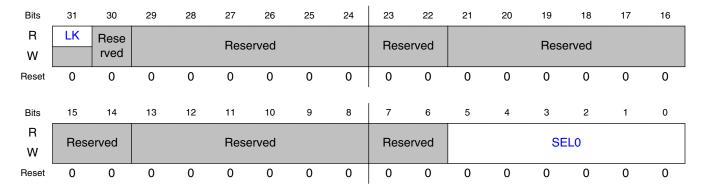
11.4.2.19 TRGMUX LPSPI0 (TRGMUX_LPSPI0)

11.4.2.19.1 Address

Register	Offset
TRGMUX_LPSPI0	4006205Ch

TRGMUX Register

11.4.2.19.2 Diagram



171

11.4.2.19.3 Fields

Field	Function
31	Enable
LK	This bit shows whether the register can be written or not.
	Register can be written. Register cannot be written until the next system Reset.
30	This read-only bit field is reserved and always has the value 0.
_	
29-24	This read-only bit field is reserved and always has the value 0.
_	
23-22	This read-only bit field is reserved and always has the value 0.
_	
21-16	This read-only bit field is reserved and always has the value 0.
_	
15-14	This read-only bit field is reserved and always has the value 0.
_	
13-8	This read-only bit field is reserved and always has the value 0.
_	
7-6	This read-only bit field is reserved and always has the value 0.
_	
5-0	Trigger MUX Input 0 Source Select
SEL0	This read/write bit field is used to configure the MUX select for peripheral trigger input 0. Refer to the Select Bit Fields table in the Features section for bit field information.

11.4.2.20 TRGMUX LPSPI1 (TRGMUX_LPSPI1)

11.4.2.20.1 Address

Register	Offset
TRGMUX_LPSPI1	40062060h

TRGMUX Register

11.4.2.20.2 Diagram

Bits	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
R	LK	Rese			Dane	n rod			Door	n rod			Door	n rad		
W		rved		Reserved						eserved Reserved						
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Bits	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
R	D				D				D				0.5	1.0		
W	Reserved				Hese	erved			Hese	erved			SE	L0		
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

11.4.2.20.3 Fields

Field	Function	
31	Enable	
LK	This bit shows whether the register can be written or not.	
	Register can be written. Register cannot be written until the next system Reset.	
30	This read-only bit field is reserved and always has the value 0.	
_		
29-24	This read-only bit field is reserved and always has the value 0.	
_		
23-22	This read-only bit field is reserved and always has the value 0.	
_		
21-16	This read-only bit field is reserved and always has the value 0.	
_		
15-14	This read-only bit field is reserved and always has the value 0.	
_		
13-8	This read-only bit field is reserved and always has the value 0.	
_		
7-6	This read-only bit field is reserved and always has the value 0.	
_		
5-0	Trigger MUX Input 0 Source Select	
SEL0	This read/write bit field is used to configure the MUX select for peripheral trigger input 0. Refer to the Select Bit Fields table in the Features section for bit field information.	

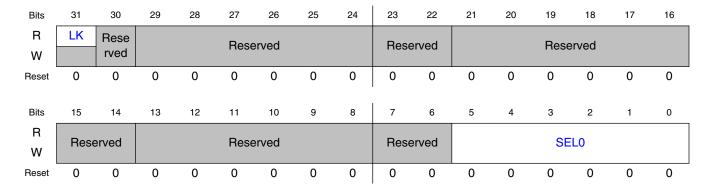
11.4.2.21 TRGMUX LPTMR0 (TRGMUX_LPTMR0)

11.4.2.21.1 Address

Register	Offset
TRGMUX_LPTMR0	40062064h

TRGMUX Register

11.4.2.21.2 Diagram



11.4.2.21.3 Fields

Field	Function		
31	Enable		
LK	This bit shows whether the register can be written or not.		
	Register can be written. Register cannot be written until the next system Reset.		
30	This read-only bit field is reserved and always has the value 0.		
_			
29-24	This read-only bit field is reserved and always has the value 0.		
_			
23-22	This read-only bit field is reserved and always has the value 0.		
_			
21-16	This read-only bit field is reserved and always has the value 0.		
_			
15-14	This read-only bit field is reserved and always has the value 0.		
_			
13-8	This read-only bit field is reserved and always has the value 0.		
_			
7-6	This read-only bit field is reserved and always has the value 0.		

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Field	Function
5-0	Trigger MUX Input 0 Source Select
SEL0	This read/write bit field is used to configure the MUX select for peripheral trigger input 0. Refer to the Select Bit Fields table in the Features section for bit field information.

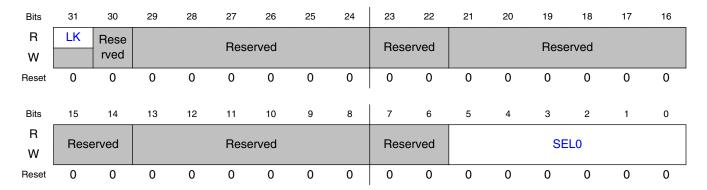
11.4.2.22 TRGMUX TSI (TRGMUX_TSI)

11.4.2.22.1 Address

Register	Offset
TRGMUX_TSI	40062068h

TRGMUX Register

11.4.2.22.2 Diagram



11.4.2.22.3 Fields

Field	Function			
31	Enable			
LK	This bit shows whether the register can be written or not.			
	Register can be written. Register cannot be written until the next system Reset.			
30	This read-only bit field is reserved and always has the value 0.			
_				
29-24	This read-only bit field is reserved and always has the value 0.			
_				

Table continues on the next page...

Chapter 11 Trigger MUX Control (TRGMUX)

Field	Function		
23-22	This read-only bit field is reserved and always has the value 0.		
_			
21-16	This read-only bit field is reserved and always has the value 0.		
_			
15-14	This read-only bit field is reserved and always has the value 0.		
_			
13-8	This read-only bit field is reserved and always has the value 0.		
_			
7-6	This read-only bit field is reserved and always has the value 0.		
_			
5-0	Trigger MUX Input 0 Source Select		
SEL0	This read/write bit field is used to configure the MUX select for peripheral trigger input 0. Refer to the Select Bit Fields table in the Features section for bit field information.		

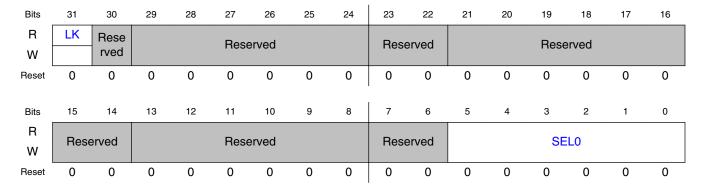
11.4.2.23 TRGMUX PWT (TRGMUX_PWT)

11.4.2.23.1 Address

Register	Offset
TRGMUX_PWT	4006206Ch

TRGMUX Register

11.4.2.23.2 Diagram



Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Usage Guide

11.4.2.23.3 Fields

Field	Function			
31	Enable			
LK	This bit shows whether the register can be written or not.			
	O - Register can be written. 1 - Register cannot be written until the next system Reset.			
30	This read-only bit field is reserved and always has the value 0.			
_				
29-24	This read-only bit field is reserved and always has the value 0.			
_				
23-22	This read-only bit field is reserved and always has the value 0.			
_				
21-16	This read-only bit field is reserved and always has the value 0.			
_				
15-14	This read-only bit field is reserved and always has the value 0.			
_				
13-8	This read-only bit field is reserved and always has the value 0.			
_				
7-6	This read-only bit field is reserved and always has the value 0.			
_				
5-0	Trigger MUX Input 0 Source Select			
SEL0	This read/write bit field is used to configure the MUX select for peripheral trigger input 0. Refer to the Select Bit Fields table in the Features section for bit field information.			

11.5 Usage Guide

The TRGMUX is an extremely flexible module interconnectivity scheme. The trigger source could be from various peripherals and external input pins, to multiple pins/ peripherals. The module level interconnections and trigger scheme offload the intervention of CPU, which is also useful when CPU is in WAIT/STOP mode. The following are some typical use-cases for TRGMUX.

11.5.1 ADC Trigger Source

The following triggers are via the TRGMUX:

• CMP out to trigger each ADC

177

- LPIT capable to trigger each ADC, LPIT supports up to 4 pre-triggers, two are for ADC0 ADHWTSA~ADHWTSB and the another two are for ADC1 ADHWTSA~ADHWTSB.
- RTC capable to trigger each ADC
- LPTMR capable to trigger each ADC

For details, please refer to "ADC Trigger Sources" section.

FTM module support counter init trigger and channel match trigger, these triggers couldbe used as trigger input of PDB, PDB then be used to trigger other modules like ADC.

For details, please refer to "ADC Trigger Concept – Use Case" section.

11.5.2 CMP Window/Sample Input

PDB and LPIT could be used to generate pulse output which can be used as sampling windows of CMP block via TRGMUX.

For details, please refer to "Window Mode" section in the CMP chapter.

11.5.3 FTM Fault Detection Input / Hardware Triggers and Synchronization

Please refer to the FTM chapter for more details.

Usage Guide

Chapter 12 Direct Memory Access Multiplexer (DMAMUX)

12.1 Chip-specific information for this module

12.1.1 DMAMUX request sources

This device includes a DMA request mux that allows up to 63 DMA request signals to be mapped to any of the 8 DMA channels. The DMA request sources could be peripheral DMA requests or always-on slots. Because of the mux, there is not a hard correlation between any of the DMA request sources and a specific DMA channel.

Some of the modules support Asynchronous DMA operation as indicated by the last column in the following DMA source assignment table. Asynchronous DMA requests can be used to activate a DMA channel in WAIT or STOP mode.

Table 12-1. DMA request sources - MUX 0

Source number	Source module	Source description	Async DMA capable
0	_	Channel disabled ¹	
1	TSI	TSI DMA Transfer	Yes
2	LPUART0	Receive	Yes
3	LPUART0	Transmit	Yes
4	LPUART1	Receive	Yes
5	LPUART1	Transmit	Yes
6	LPUART2	Receive	Yes
7	LPUART2	Transmit	Yes
8	Reserved	-	
9	Reserved	-	
10	FlexIO	Shifter0	Yes
11	FlexIO	Shifter1	Yes
12	FlexIO	Shifter2	Yes

Table continues on the next page...

Table 12-1. DMA request sources - MUX 0 (continued)

Source number	Source module	Source description	Async DMA capable
13	FlexIO	Shifter3	Yes
14	LPSPI0	Receive	Yes
15	LPSPI0	Transmit	Yes
16	LPSPI1	Receive	Yes
17	LPSPI1	Transmit	Yes
18	LPI ² C0	Receive	Yes
19	LPI ² C0	Transmit	Yes
20	FTM0	Channel 0	
21	FTM0	Channel 1	
22	FTM0	Channel 2	
23	FTM0	Channel 3	
24	FTM0	Channel 4	
25	FTM0	Channel 5	
26	FTM0	Channel 6	
27	FTM0	Channel 7	
28	FTM1	Channel 0	
29	FTM1	Channel 1	
30	FTM2	Channel 0	
31	FTM2	Channel 1	
32	LPI ² C1	LPI ² C1 Receive	Yes for LPI ² C1
33	LPI ² C1	LPI ² C1 Transmit	Yes for LPI ² C1
34	Reserved	_	
35	Reserved	_	
36	Reserved	_	
37	Reserved	_	
38	Reserved	_	
39	Reserved	_	
40	ADC0	ADC0 COCO	Yes
41	ADC1	ADC1 COCO	Yes
42	Reserved	_	
43	CMP0	_	Yes
44	CMP1	_	Yes
45	Reserved	_	
46	PDB0	-	
47	Reserved	_	
48	Reserved	_	
49	Port control module	Port A	Yes

Table continues on the next page...

Table 12-1. DMA request sources - MUX 0 (continued)

Source number	Source module	Source description	Async DMA capable
50	Port control module	Port B	Yes
51	Port control module	Port C	Yes
52	Port control module	Port D	Yes
53	Port control module	Port E	Yes
54	Reserved	_	
55	Reserved	_	
56	Reserved		
57	FTM1	OR of ch2-ch3	
58	FTM2	OR of ch2-ch3	
59	LPTMR0	_	Yes
60	DMAMUX	Always enabled	
61	DMAMUX	Always enabled	
62	DMAMUX	Always enabled	
63	DMAMUX	Always enabled	

^{1.} Configuring a DMA channel to select source 0 or any of the reserved sources disables that DMA channel.

12.1.2 **DMA** trigger sources

The DMAMUX on this device also supports a periodic trigger mode. The trigger sources are from TRGMUX output showed in following table. The triggers from TRGMUX module can trigger a DMA transfer on the first four DMA channels (channel 0 -3), for example, the LPIT can trigger DMA via TRGMUX.

Table 12-2. DMAMUX trigger sources

Trigger number	Trigger module	Trigger description	
0	TRGMUX	TRGMUX trigger out0	
1	TRGMUX	TRGMUX trigger out1	
2	TRGMUX	TRGMUX trigger out2	
3	TRGMUX	TRGMUX trigger out3	

12.2 Introduction

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018 **NXP Semiconductors** 181

12.2.1 Overview

The Direct Memory Access Multiplexer (DMAMUX) routes DMA sources, called slots, to any of the 8 DMA channels. This process is illustrated in the following figure.

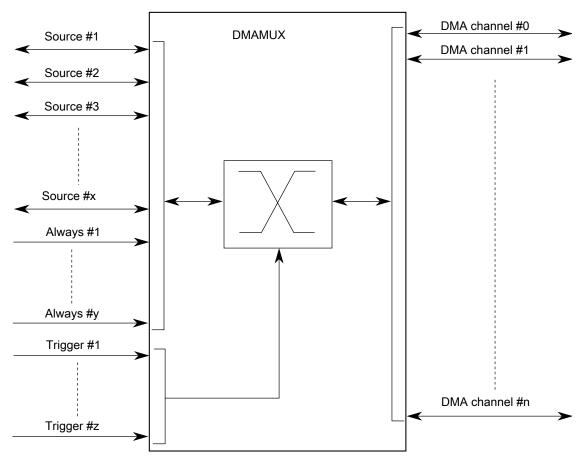


Figure 12-1. DMAMUX block diagram

12.2.2 Features

The DMAMUX module provides these features:

- Up to 59 peripheral slots and up to four always-on slots can be routed to 8 channels.
- 8 independently selectable DMA channel routers.
 - The first four channels additionally provide a trigger functionality.
- Each channel router can be assigned to one of the possible peripheral DMA slots or to one of the always-on slots.

12.2.3 Modes of operation

The following operating modes are available:

• Disabled mode

In this mode, the DMA channel is disabled. Because disabling and enabling of DMA channels is done primarily via the DMA configuration registers, this mode is used mainly as the reset state for a DMA channel in the DMA channel MUX. It may also be used to temporarily suspend a DMA channel while reconfiguration of the system takes place, for example, changing the period of a DMA trigger.

Normal mode

In this mode, a DMA source is routed directly to the specified DMA channel. The operation of the DMAMUX in this mode is completely transparent to the system.

• Periodic Trigger mode

In this mode, a DMA source may only request a DMA transfer, such as when a transmit buffer becomes empty or a receive buffer becomes full, periodically.

Configuration of the period is done in the registers of the periodic interrupt timer (LPIT). This mode is available only for channels 0–3.

12.3 External signal description

The DMAMUX has no external pins.

12.4 Memory map/register definition

This section provides a detailed description of all memory-mapped registers in the DMAMUX.

DMAMUX memory map

Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page
4002_1000	Channel Configuration register (DMAMUX_CHCFG0)	8	R/W	00h	12.4.1/184
4002_1001	Channel Configuration register (DMAMUX_CHCFG1)	8	R/W	00h	12.4.1/184
4002_1002	Channel Configuration register (DMAMUX_CHCFG2)	8	R/W	00h	12.4.1/184
4002_1003	Channel Configuration register (DMAMUX_CHCFG3)	8	R/W	00h	12.4.1/184

Table continues on the next page...

183

Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page
4002_1004	Channel Configuration register (DMAMUX_CHCFG4)	8	R/W	00h	12.4.1/184
4002_1005	Channel Configuration register (DMAMUX_CHCFG5)	8	R/W	00h	12.4.1/184
4002_1006	Channel Configuration register (DMAMUX_CHCFG6)	8	R/W	00h	12.4.1/184
4002_1007	Channel Configuration register (DMAMUX_CHCFG7)	8	R/W	00h	12.4.1/184

12.4.1 Channel Configuration register (DMAMUX_CHCFGn)

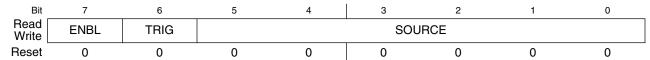
Each of the DMA channels can be independently enabled/disabled and associated with one of the DMA slots (peripheral slots or always-on slots) in the system.

NOTE

Setting multiple CHCFG registers with the same source value will result in unpredictable behavior. This is true, even if a channel is disabled (ENBL==0).

Before changing the trigger or source settings, a DMA channel must be disabled via CHCFGn[ENBL].

Address: 4002_1000h base + 0h offset + $(1d \times i)$, where i=0d to 7d



DMAMUX_CHCFGn field descriptions

Field	Description
7 ENBL	DMA Channel Enable
LIVE	Enables the DMA channel.
	O DMA channel is disabled. This mode is primarily used during configuration of the DMAMux. The DMA has separate channel enables/disables, which should be used to disable or reconfigure a DMA channel.
	1 DMA channel is enabled
6 TRIG	DMA Channel Trigger Enable
ITTIO	Enables the periodic trigger capability for the triggered DMA channel.
	O Triggering is disabled. If triggering is disabled and ENBL is set, the DMA Channel will simply route the specified source to the DMA channel. (Normal mode)
	1 Triggering is enabled. If triggering is enabled and ENBL is set, the DMAMUX is in Periodic Trigger mode.
SOURCE	DMA Channel Source (Slot)

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

DMAMUX_CHCFGn field descriptions (continued)

Field	Description			
	Specifies which DMA source, if any, is routed to a particular DMA channel. See the chip-specific DMAMUX information for details about the peripherals and their slot numbers.			

12.5 Functional description

The primary purpose of the DMAMUX is to provide flexibility in the system's use of the available DMA channels.

As such, configuration of the DMAMUX is intended to be a static procedure done during execution of the system boot code. However, if the procedure outlined in Enabling and configuring sources is followed, the configuration of the DMAMUX may be changed during the normal operation of the system.

Functionally, the DMAMUX channels may be divided into two classes:

- Channels that implement the normal routing functionality plus periodic triggering capability
- Channels that implement only the normal routing functionality

12.5.1 DMA channels with periodic triggering capability

Besides the normal routing functionality, the first 4 channels of the DMAMUX provide a special periodic triggering capability that can be used to provide an automatic mechanism to transmit bytes, frames, or packets at fixed intervals without the need for processor intervention.

The trigger is generated by the periodic interrupt timer (LPIT); as such, the configuration of the periodic triggering interval is done via configuration registers in the LPIT. See the section on periodic interrupt timer for more information on this topic.

Note

Because of the dynamic nature of the system (due to DMA channel priorities, bus arbitration, interrupt service routine lengths, etc.), the number of clock cycles between a trigger and the actual DMA transfer cannot be guaranteed.

NXP Semiconductors

185

Functional description

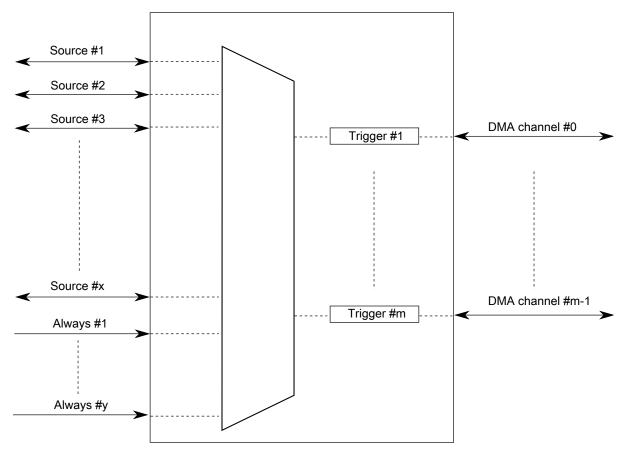


Figure 12-2. DMAMUX triggered channels

The DMA channel triggering capability allows the system to schedule regular DMA transfers, usually on the transmit side of certain peripherals, without the intervention of the processor. This trigger works by gating the request from the peripheral to the DMA until a trigger event has been seen. This is illustrated in the following figure.

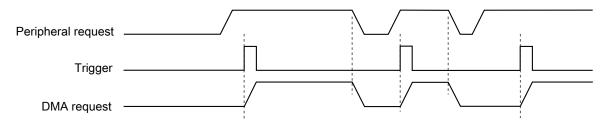


Figure 12-3. DMAMUX channel triggering: normal operation

After the DMA request has been serviced, the peripheral will negate its request, effectively resetting the gating mechanism until the peripheral reasserts its request and the next trigger event is seen. This means that if a trigger is seen, but the peripheral is not requesting a transfer, then that trigger will be ignored. This situation is illustrated in the following figure.

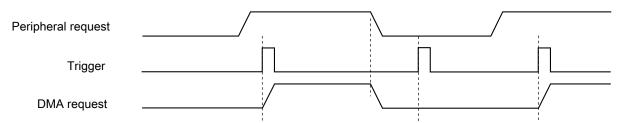


Figure 12-4. DMAMUX channel triggering: ignored trigger

This triggering capability may be used with any peripheral that supports DMA transfers, and is most useful for two types of situations:

• Periodically polling external devices on a particular bus

As an example, the transmit side of an SPI is assigned to a DMA channel with a trigger, as described above. After it has been set up, the SPI will request DMA transfers, presumably from memory, as long as its transmit buffer is empty. By using a trigger on this channel, the SPI transfers can be automatically performed every 5 μ s (as an example). On the receive side of the SPI, the SPI and DMA can be configured to transfer receive data into memory, effectively implementing a method to periodically read data from external devices and transfer the results into memory without processor intervention.

• Using the GPIO ports to drive or sample waveforms

By configuring the DMA to transfer data to one or more GPIO ports, it is possible to create complex waveforms using tabular data stored in on-chip memory. Conversely, using the DMA to periodically transfer data from one or more GPIO ports, it is possible to sample complex waveforms and store the results in tabular form in on-chip memory.

A more detailed description of the capability of each trigger, including resolution, range of values, and so on, may be found in the periodic interrupt timer section.

12.5.2 DMA channels with no triggering capability

The other channels of the DMAMUX provide the normal routing functionality as described in Modes of operation.

12.5.3 Always-enabled DMA sources

In addition to the peripherals that can be used as DMA sources, there are four additional DMA sources that are always enabled. Unlike the peripheral DMA sources, where the peripheral controls the flow of data during DMA transfers, the sources that are always enabled provide no such "throttling" of the data transfers. These sources are most useful in the following cases:

- Performing DMA transfers to/from GPIO—Moving data from/to one or more GPIO pins, either unthrottled (that is, as fast as possible), or periodically (using the DMA triggering capability).
- Performing DMA transfers from memory to memory—Moving data from memory to memory, typically as fast as possible, sometimes with software activation.
- Performing DMA transfers from memory to the external bus, or vice-versa—Similar to memory to memory transfers, this is typically done as quickly as possible.
- Any DMA transfer that requires software activation—Any DMA transfer that should be explicitly started by software.

In cases where software should initiate the start of a DMA transfer, an always-enabled DMA source can be used to provide maximum flexibility. When activating a DMA channel via software, subsequent executions of the minor loop require that a new start event be sent. This can either be a new software activation, or a transfer request from the DMA channel MUX. The options for doing this are:

• Transfer all data in a single minor loop.

By configuring the DMA to transfer all of the data in a single minor loop (that is, major loop counter = 1), no reactivation of the channel is necessary. The disadvantage to this option is the reduced granularity in determining the load that the DMA transfer will impose on the system. For this option, the DMA channel must be disabled in the DMA channel MUX.

• Use explicit software reactivation.

In this option, the DMA is configured to transfer the data using both minor and major loops, but the processor is required to reactivate the channel by writing to the DMA registers *after every minor loop*. For this option, the DMA channel must be disabled in the DMA channel MUX.

• Use an always-enabled DMA source.

189

In this option, the DMA is configured to transfer the data using both minor and major loops, and the DMA channel MUX does the channel reactivation. For this option, the DMA channel should be enabled and pointing to an "always enabled" source. Note that the reactivation of the channel can be continuous (DMA triggering is disabled) or can use the DMA triggering capability. In this manner, it is possible to execute periodic transfers of packets of data from one source to another, without processor intervention.

12.6 Initialization/application information

This section provides instructions for initializing the DMA channel MUX.

12.6.1 Reset

The reset state of each individual bit is shown in Memory map/register definition. In summary, after reset, all channels are disabled and must be explicitly enabled before use.

12.6.2 Enabling and configuring sources

To enable a source with periodic triggering:

- 1. Determine with which DMA channel the source will be associated. Note that only the first 4 DMA channels have periodic triggering capability.
- 2. Clear the CHCFG[ENBL] and CHCFG[TRIG] fields of the DMA channel.
- 3. Ensure that the DMA channel is properly configured in the DMA. The DMA channel may be enabled at this point.
- 4. Configure the corresponding timer.
- 5. Select the source to be routed to the DMA channel. Write to the corresponding CHCFG register, ensuring that the CHCFG[ENBL] and CHCFG[TRIG] fields are set.

NOTE

The following is an example. See the chip configuration details for the number of this device's DMA channels that have triggering capability.

To configure source #5 transmit for use with DMA channel 1, with periodic triggering capability:

1. Write 0x00 to CHCFG1.

Initialization/application information

- 2. Configure channel 1 in the DMA, including enabling the channel.
- 3. Configure a timer for the desired trigger interval.
- 4. Write 0xC5 to CHCFG1.

The following code example illustrates steps 1 and 4 above:

```
void DMAMUX_Init(uint8_t DMA_CH, uint8_t DMAMUX_SOURCE)
{
    DMAMUX_0.CHCFG[DMA_CH].B.SOURCE = DMAMUX_SOURCE;
    DMAMUX_0.CHCFG[DMA_CH].B.ENBL = 1;
    DMAMUX_0.CHCFG[DMA_CH].B.TRIG = 1;
}
```

To enable a source, without periodic triggering:

- 1. Determine with which DMA channel the source will be associated. Note that only the first 4 DMA channels have periodic triggering capability.
- 2. Clear the CHCFG[ENBL] and CHCFG[TRIG] fields of the DMA channel.
- 3. Ensure that the DMA channel is properly configured in the DMA. The DMA channel may be enabled at this point.
- 4. Select the source to be routed to the DMA channel. Write to the corresponding CHCFG register, ensuring that CHCFG[ENBL] is set while CHCFG[TRIG] is cleared.

NOTE

The following is an example. See the chip configuration details for the number of this device's DMA channels that have triggering capability.

To configure source #5 transmit for use with DMA channel 1, with no periodic triggering capability:

- 1. Write 0x00 to CHCFG1.
- 2. Configure channel 1 in the DMA, including enabling the channel.
- 3. Write 0x85 to CHCFG1.

The following code example illustrates steps 1 and 3 above:

```
In File registers.h:
#define DMAMUX BASE ADDR
                             0x40021000/* Example only ! */
/* Following example assumes char is 8-bits */
volatile unsigned char *CHCFG0 = (volatile unsigned char *) (DMAMUX BASE ADDR+0x0000);
volatile unsigned char *CHCFG1 = (volatile unsigned char *) (DMAMUX BASE ADDR+0x0001);
volatile unsigned char *CHCFG2 = (volatile unsigned char *) (DMAMUX BASE ADDR+0x0002);
volatile unsigned char *CHCFG3 = (volatile unsigned char *) (DMAMUX_BASE_ADDR+0x0003);
volatile unsigned char *CHCFG4 = (volatile unsigned char *) (DMAMUX BASE ADDR+0x0004);
volatile unsigned char *CHCFG5 = (volatile unsigned char *) (DMAMUX_BASE_ADDR+0x0005);
volatile unsigned char *CHCFG6 = (volatile unsigned char *) (DMAMUX_BASE_ADDR+0x0006);
volatile unsigned char *CHCFG7 = (volatile unsigned char *) (DMAMUX BASE ADDR+0x0007);
volatile unsigned char *CHCFG8 = (volatile unsigned char *) (DMAMUX BASE ADDR+0x0008);
volatile unsigned char *CHCFG9 = (volatile unsigned char *) (DMAMUX_BASE_ADDR+0x0009);
volatile unsigned char *CHCFG10= (volatile unsigned char *) (DMAMUX_BASE_ADDR+0x000A);
volatile unsigned char *CHCFG11= (volatile unsigned char *) (DMAMUX BASE ADDR+0x000B);
volatile unsigned char *CHCFG12= (volatile unsigned char *) (DMAMUX_BASE_ADDR+0x000C);
volatile unsigned char *CHCFG13= (volatile unsigned char *) (DMAMUX BASE ADDR+0x000D);
```

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Chapter 12 Direct Memory Access Multiplexer (DMAMUX)

191

To disable a source:

A particular DMA source may be disabled by not writing the corresponding source value into any of the CHCFG registers. Additionally, some module-specific configuration may be necessary. See the appropriate section for more details.

To switch the source of a DMA channel:

- 1. Disable the DMA channel in the DMA and reconfigure the channel for the new source.
- 2. Clear the CHCFG[ENBL] and CHCFG[TRIG] bits of the DMA channel.
- 3. Select the source to be routed to the DMA channel. Write to the corresponding CHCFG register, ensuring that the CHCFG[ENBL] and CHCFG[TRIG] fields are set.

To switch DMA channel 8 from source #5 transmit to source #7 transmit:

- 1. In the DMA configuration registers, disable DMA channel 8 and reconfigure it to handle the transfers to peripheral slot 7. This example assumes channel 8 doesn't have triggering capability.
- 2. Write 0x00 to CHCFG8.
- 3. Write 0x87 to CHCFG8. (In this example, setting CHCFG[TRIG] would have no effect due to the assumption that channel 8 does not support the periodic triggering functionality.)

The following code example illustrates steps 2 and 3 above:

```
In File registers.h:
#define DMAMUX BASE ADDR
                             0x40021000/* Example only ! */
/* Following example assumes char is 8-bits */
volatile unsigned char *CHCFG0 = (volatile unsigned char *) (DMAMUX BASE ADDR+0x0000);
volatile unsigned char *CHCFG1 = (volatile unsigned char *) (DMAMUX BASE ADDR+0x0001);
volatile unsigned char *CHCFG2 = (volatile unsigned char *) (DMAMUX_BASE_ADDR+0x0002);
volatile unsigned char *CHCFG3 = (volatile unsigned char *) (DMAMUX_BASE_ADDR+0x0003);
volatile unsigned char *CHCFG4 = (volatile unsigned char *) (DMAMUX_BASE_ADDR+0x0004);
volatile unsigned char *CHCFG5 = (volatile unsigned char *) (DMAMUX_BASE_ADDR+0x0005);
volatile unsigned char *CHCFG6 = (volatile unsigned char *) (DMAMUX BASE ADDR+0x0006);
volatile unsigned char *CHCFG7 = (volatile unsigned char *) (DMAMUX_BASE_ADDR+0x0007);
volatile unsigned char *CHCFG8 = (volatile unsigned char *) (DMAMUX_BASE_ADDR+0x0008);
volatile unsigned char *CHCFG9 = (volatile unsigned char *)
                                                            (DMAMUX_BASE_ADDR+0x0009);
volatile unsigned char *CHCFG10= (volatile unsigned char *)
                                                            (DMAMUX BASE ADDR+0x000A);
volatile unsigned char *CHCFG11= (volatile unsigned char *) (DMAMUX_BASE_ADDR+0x000B);
volatile unsigned char *CHCFG12= (volatile unsigned char *) (DMAMUX_BASE_ADDR+0x000C);
volatile unsigned char *CHCFG13= (volatile unsigned char *) (DMAMUX BASE ADDR+0x000D);
volatile unsigned char *CHCFG14= (volatile unsigned char *) (DMAMUX BASE ADDR+0x000E);
volatile unsigned char *CHCFG15= (volatile unsigned char *) (DMAMUX_BASE_ADDR+0x000F);
```

Initialization/application information

```
In File main.c:
#include "registers.h"
:
:
*CHCFG8 = 0x00;
*CHCFG8 = 0x87;
```

Chapter 13 Enhanced Direct Memory Access (eDMA)

13.1 Introduction

The enhanced direct memory access (eDMA) controller is a second-generation module capable of performing complex data transfers with minimal intervention from a host processor. The hardware microarchitecture includes:

- A DMA engine that performs:
 - Source address and destination address calculations
 - Data-movement operations
- Local memory containing transfer control descriptors for each of the 8 channels

13.1.1 eDMA system block diagram

Figure 13-1 illustrates the components of the eDMA system, including the eDMA module ("engine").

Introduction

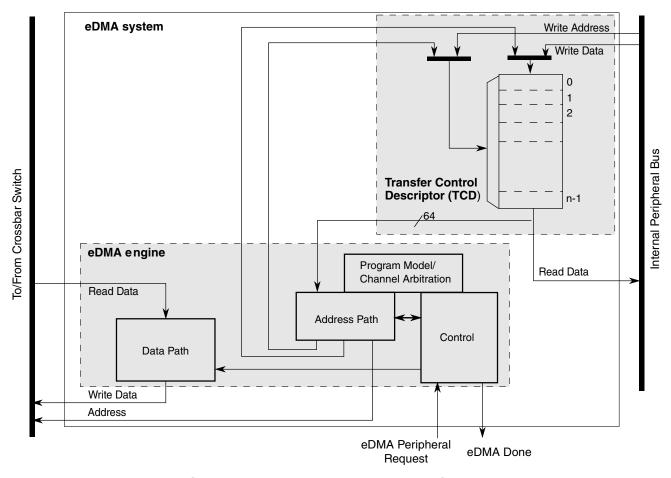


Figure 13-1. eDMA system block diagram

13.1.2 Block parts

The eDMA module is partitioned into two major modules: the eDMA engine and the transfer-control descriptor local memory.

The eDMA engine is further partitioned into four submodules:

Table 13-1. eDMA engine submodules

Submodule	Function
Address path	This block implements registered versions of two channel transfer control descriptors, channel x and channel y, and manages all master bus-address calculations. All the channels provide the same functionality. This structure allows data transfers associated with one channel to be preempted after the completion of a read/write sequence if a higher priority channel activation is asserted while the first channel is active. After a channel is activated, it runs until the minor loop is completed, unless preempted by a higher priority channel. This provides a mechanism (enabled by DCHPRIn[ECP]) where a large data move operation can be preempted to minimize the time another channel is blocked from execution.
	When any channel is selected to execute, the contents of its TCD are read from local memory and loaded into the address path channel x registers for a normal start and into channel y registers for a preemption start. After the minor loop completes execution, the address path hardware writes

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Table 13-1. eDMA engine submodules (continued)

Submodule	Function
	the new values for the TCDn_{SADDR, DADDR, CITER} back to local memory. If the major iteration count is exhausted, additional processing is performed, including the final address pointer updates, reloading the TCDn_CITER field, and a possible fetch of the next TCDn from memory as part of a scatter/gather operation.
Data path	This block implements the bus master read/write datapath. It includes a data buffer and the necessary multiplex logic to support any required data alignment. The internal read data bus is the primary input, and the internal write data bus is the primary output.
	The address and data path modules directly support the 2-stage pipelined internal bus. The address path module represents the 1st stage of the bus pipeline (address phase), while the data path module implements the 2nd stage of the pipeline (data phase).
Program model/channel arbitration	This block implements the first section of the eDMA programming model as well as the channel arbitration logic. The programming model registers are connected to the internal peripheral bus. The eDMA peripheral request inputs and interrupt request outputs are also connected to this block (via control logic).
Control	This block provides all the control functions for the eDMA engine. For data transfers where the source and destination sizes are equal, the eDMA engine performs a series of source read/destination write operations until the number of bytes specified in the minor loop byte count has moved. For descriptors where the sizes are not equal, multiple accesses of the smaller size data are required for each reference of the larger size. As an example, if the source size references 16-bit data and the destination is 32-bit data, two reads are performed, then one 32-bit write.

The transfer-control descriptor local memory is further partitioned into:

Table 13-2. Transfer control descriptor memory

Submodule	Description
Memory controller	This logic implements the required dual-ported controller, managing accesses from the eDMA engine as well as references from the internal peripheral bus. As noted earlier, in the event of simultaneous accesses, the eDMA engine is given priority and the peripheral transaction is stalled.
Memory array	TCD storage for each channel's transfer profile.

13.1.3 Features

The eDMA is a highly programmable data-transfer engine optimized to minimize any required intervention from the host processor. It is intended for use in applications where the data size to be transferred is statically known and not defined within the transferred data itself. The eDMA module features:

- All data movement via dual-address transfers: read from source, write to destination
 - Programmable source and destination addresses and transfer size
 - Support for enhanced addressing modes

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Modes of operation

- 8-channel implementation that performs complex data transfers with minimal intervention from a host processor
 - Connections to the crossbar switch for bus mastering the data movement
- Transfer control descriptor (TCD) organized to support two-deep, nested transfer operations
 - 32-byte TCD stored in local memory for each channel
 - An inner data transfer loop defined by a minor byte transfer count
 - An outer data transfer loop defined by a major iteration count
- Channel activation via one of three methods:
 - Explicit software initiation
 - Initiation via a channel-to-channel linking mechanism for continuous transfers
 - Peripheral-paced hardware requests, one per channel
- Fixed-priority and round-robin channel arbitration
- Channel completion reported via programmable interrupt requests
 - One interrupt per channel, which can be asserted at completion of major iteration count
 - Programmable error terminations per channel and logically summed together to form one error interrupt to the interrupt controller
- Programmable support for scatter/gather DMA processing
- Support for complex data structures

In the discussion of this module, n is used to reference the channel number.

13.2 Modes of operation

The eDMA operates in the following modes:

Table 13-3. Modes of operation

Mode	Description
	In Normal mode, the eDMA transfers data between a source and a destination. The source and destination can be a memory block or an I/O block capable of operation with the eDMA.

Table continues on the next page...

196 NX

Table 13-3. Modes of operation (continued)

Mode	Description			
	A service request initiates a transfer of a specific number of bytes (NBYTES) as specified in the transfer control descriptor (TCD). The minor loop is the sequence of read-write operations that transfers these NBYTES per service request. Each service request executes one iteration of the major loop, which transfers NBYTES of data.			
Debug	DMA operation is configurable in Debug mode via the control register:			
	 If CR[EDBG] is cleared, the DMA continues to operate. If CR[EDBG] is set, the eDMA stops transferring data. If Debug mode is entered while a channel is active, the eDMA continues operation until the channel retires. 			
Wait	Before entering Wait mode, the DMA attempts to complete its current transfer. After the transfer completes, the device enters Wait mode.			

13.3 Memory map/register definition

The eDMA's programming model is partitioned into two regions:

- The first region defines a number of registers providing control functions
- The second region corresponds to the local transfer control descriptor (TCD) memory

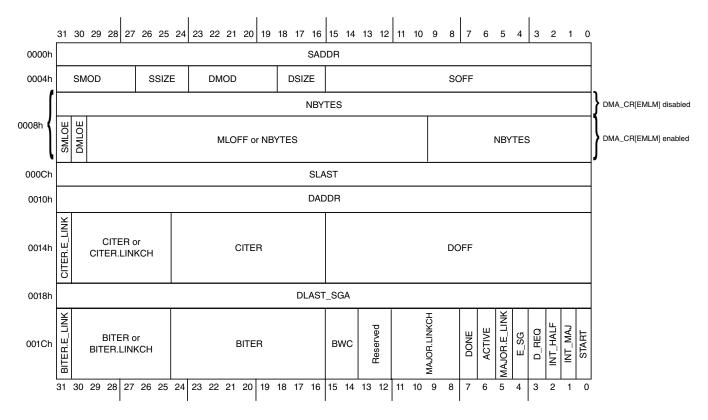
13.3.1 TCD memory

Each channel requires a 32-byte transfer control descriptor for defining the desired data movement operation. The channel descriptors are stored in the local memory in sequential order: channel 0, channel 1, ... channel 7. Each TCD*n* definition is presented as 11 registers of 16 or 32 bits.

13.3.2 TCD initialization

Prior to activating a channel, you must initialize its TCD with the appropriate transfer profile.

13.3.3 TCD structure



13.3.4 Reserved memory and bit fields

- Reading reserved bits in a register returns the value of zero.
- Writes to reserved bits in a register are ignored.
- Reading or writing a reserved memory location generates a bus error.

DMA memory map

Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page
4000_8000	Control Register (DMA_CR)	32	R/W	See section	13.3.5/204
4000_8004	Error Status Register (DMA_ES)	32	R	0000_0000h	13.3.6/207
4000_800C	Enable Request Register (DMA_ERQ)	32	R/W	0000_0000h	13.3.7/209
4000_8014	Enable Error Interrupt Register (DMA_EEI)	32	R/W	0000_0000h	13.3.8/211
4000_8018	Clear Enable Error Interrupt Register (DMA_CEEI)	8	W (always reads 0)	00h	13.3.9/212
4000_8019	Set Enable Error Interrupt Register (DMA_SEEI)	8	W (always reads 0)	00h	13.3.10/213

Table continues on the next page...

Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page
4000_801A	Clear Enable Request Register (DMA_CERQ)	8	W (always reads 0)	00h	13.3.11/214
4000_801B	Set Enable Request Register (DMA_SERQ)	8	W (always reads 0)	00h	13.3.12/215
4000_801C	Clear DONE Status Bit Register (DMA_CDNE)	8	W (always reads 0)	00h	13.3.13/216
4000_801D	Set START Bit Register (DMA_SSRT)	8	W (always reads 0)	00h	13.3.14/217
4000_801E	Clear Error Register (DMA_CERR)	8	W (always reads 0)	00h	13.3.15/218
4000_801F	Clear Interrupt Request Register (DMA_CINT)	8	W (always reads 0)	00h	13.3.16/219
4000_8024	Interrupt Request Register (DMA_INT)	32	R/W	0000_0000h	13.3.17/220
4000_802C	Error Register (DMA_ERR)	32	R/W	0000_0000h	13.3.18/221
4000_8034	Hardware Request Status Register (DMA_HRS)	32	R	0000_0000h	13.3.19/223
4000_8044	Enable Asynchronous Request in Stop Register (DMA_EARS)	32	R/W	0000_0000h	13.3.20/225
4000_8100	Channel n Priority Register (DMA_DCHPRI3)	8	R/W	See section	13.3.21/226
4000_8101	Channel n Priority Register (DMA_DCHPRI2)	8	R/W	See section	13.3.21/226
4000_8102	Channel n Priority Register (DMA_DCHPRI1)	8	R/W	See section	13.3.21/226
4000_8103	Channel n Priority Register (DMA_DCHPRI0)	8	R/W	See section	13.3.21/226
4000_8104	Channel n Priority Register (DMA_DCHPRI7)	8	R/W	See section	13.3.21/226
4000_8105	Channel n Priority Register (DMA_DCHPRI6)	8	R/W	See section	13.3.21/226
4000_8106	Channel n Priority Register (DMA_DCHPRI5)	8	R/W	See section	13.3.21/226
4000_8107	Channel n Priority Register (DMA_DCHPRI4)	8	R/W	See section	13.3.21/226
4000_9000	TCD Source Address (DMA_TCD0_SADDR)	32	R/W	Undefined	13.3.22/227
4000_9004	TCD Signed Source Address Offset (DMA_TCD0_SOFF)	16	R/W	Undefined	13.3.23/227
4000_9006	TCD Transfer Attributes (DMA_TCD0_ATTR)	16	R/W	Undefined	13.3.24/228
4000_9008	TCD Minor Byte Count (Minor Loop Mapping Disabled) (DMA_TCD0_NBYTES_MLNO)	32	R/W	Undefined	13.3.25/229
4000_9008	TCD Signed Minor Loop Offset (Minor Loop Mapping Enabled and Offset Disabled) (DMA_TCD0_NBYTES_MLOFFNO)	32	R/W	Undefined	13.3.26/229
4000_9008	TCD Signed Minor Loop Offset (Minor Loop Mapping and Offset Enabled) (DMA_TCD0_NBYTES_MLOFFYES)	32	R/W	Undefined	13.3.27/231
4000_900C	TCD Last Source Address Adjustment (DMA_TCD0_SLAST)	32	R/W	Undefined	13.3.28/232

Table continues on the next page...

Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page
4000_9010	TCD Destination Address (DMA_TCD0_DADDR)	32	R/W	Undefined	13.3.29/232
	TCD Signed Destination Address Offset (DMA_TCD0_DOFF)	16	R/W	Undefined	13.3.30/233
	TCD Current Minor Loop Link, Major Loop Count (Channel Linking Enabled) (DMA_TCD0_CITER_ELINKYES)	16	R/W	Undefined	13.3.31/233
4000_9016	DMA_TCD0_CITER_ELINKNO	16	R/W	Undefined	13.3.32/235
	TCD Last Destination Address Adjustment/Scatter Gather Address (DMA_TCD0_DLASTSGA)	32	R/W	Undefined	13.3.33/236
4000_901C	TCD Control and Status (DMA_TCD0_CSR)	16	R/W	Undefined	13.3.34/236
4000_901E	TCD Beginning Minor Loop Link, Major Loop Count (Channel Linking Enabled) (DMA_TCD0_BITER_ELINKYES)	16	R/W	Undefined	13.3.35/239
	TCD Beginning Minor Loop Link, Major Loop Count (Channel Linking Disabled) (DMA_TCD0_BITER_ELINKNO)	16	R/W	Undefined	13.3.36/240
4000_9020	TCD Source Address (DMA_TCD1_SADDR)	32	R/W	Undefined	13.3.22/227
4000_9024	TCD Signed Source Address Offset (DMA_TCD1_SOFF)	16	R/W	Undefined	13.3.23/227
4000_9026	TCD Transfer Attributes (DMA_TCD1_ATTR)	16	R/W	Undefined	13.3.24/228
	TCD Minor Byte Count (Minor Loop Mapping Disabled) (DMA_TCD1_NBYTES_MLNO)	32	R/W	Undefined	13.3.25/229
4000_9028	TCD Signed Minor Loop Offset (Minor Loop Mapping Enabled and Offset Disabled) (DMA_TCD1_NBYTES_MLOFFNO)	32	R/W	Undefined	13.3.26/229
	TCD Signed Minor Loop Offset (Minor Loop Mapping and Offset Enabled) (DMA_TCD1_NBYTES_MLOFFYES)	32	R/W	Undefined	13.3.27/231
	TCD Last Source Address Adjustment (DMA_TCD1_SLAST)	32	R/W	Undefined	13.3.28/232
4000_9030	TCD Destination Address (DMA_TCD1_DADDR)	32	R/W	Undefined	13.3.29/232
ZITICICI GENERALI	TCD Signed Destination Address Offset (DMA_TCD1_DOFF)	16	R/W	Undefined	13.3.30/233
	TCD Current Minor Loop Link, Major Loop Count (Channel Linking Enabled) (DMA_TCD1_CITER_ELINKYES)	16	R/W	Undefined	13.3.31/233
4000_9036	DMA_TCD1_CITER_ELINKNO	16	R/W	Undefined	13.3.32/235
	TCD Last Destination Address Adjustment/Scatter Gather Address (DMA_TCD1_DLASTSGA)	32	R/W	Undefined	13.3.33/236
4000_903C	TCD Control and Status (DMA_TCD1_CSR)	16	R/W	Undefined	13.3.34/236
4000_903E	TCD Beginning Minor Loop Link, Major Loop Count (Channel Linking Enabled) (DMA_TCD1_BITER_ELINKYES)	16	R/W	Undefined	13.3.35/239
	TCD Beginning Minor Loop Link, Major Loop Count (Channel Linking Disabled) (DMA_TCD1_BITER_ELINKNO)	16	R/W	Undefined	13.3.36/240
4000_9040	TCD Source Address (DMA_TCD2_SADDR)	32	R/W	Undefined	13.3.22/227
4000_9044	TCD Signed Source Address Offset (DMA_TCD2_SOFF)	16	R/W	Undefined	13.3.23/227

Table continues on the next page...

Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page
4000_9048	TCD Minor Byte Count (Minor Loop Mapping Disabled) (DMA_TCD2_NBYTES_MLNO)	32	R/W	Undefined	13.3.25/229
4000_9048	TCD Signed Minor Loop Offset (Minor Loop Mapping Enabled and Offset Disabled) (DMA_TCD2_NBYTES_MLOFFNO)	32	R/W	Undefined	13.3.26/229
4000_9048	TCD Signed Minor Loop Offset (Minor Loop Mapping and Offset Enabled) (DMA_TCD2_NBYTES_MLOFFYES)	32	R/W	Undefined	13.3.27/231
4000_904C	TCD Last Source Address Adjustment (DMA_TCD2_SLAST)	32	R/W	Undefined	13.3.28/232
4000_9050	TCD Destination Address (DMA_TCD2_DADDR)	32	R/W	Undefined	13.3.29/232
4000_9054	TCD Signed Destination Address Offset (DMA_TCD2_DOFF)	16	R/W	Undefined	13.3.30/233
4000_9056	TCD Current Minor Loop Link, Major Loop Count (Channel Linking Enabled) (DMA_TCD2_CITER_ELINKYES)	16	R/W	Undefined	13.3.31/233
4000_9056	DMA_TCD2_CITER_ELINKNO	16	R/W	Undefined	13.3.32/235
4000_9058	TCD Last Destination Address Adjustment/Scatter Gather Address (DMA_TCD2_DLASTSGA)	32	R/W	Undefined	13.3.33/236
4000_905C	TCD Control and Status (DMA_TCD2_CSR)	16	R/W	Undefined	13.3.34/236
4000_905E	TCD Beginning Minor Loop Link, Major Loop Count (Channel Linking Enabled) (DMA_TCD2_BITER_ELINKYES)	16	R/W	Undefined	13.3.35/239
4000_905E	TCD Beginning Minor Loop Link, Major Loop Count (Channel Linking Disabled) (DMA_TCD2_BITER_ELINKNO)	16	R/W	Undefined	13.3.36/240
4000_9060	TCD Source Address (DMA_TCD3_SADDR)	32	R/W	Undefined	13.3.22/227
4000_9064	TCD Signed Source Address Offset (DMA_TCD3_SOFF)	16	R/W	Undefined	13.3.23/227
4000_9066	TCD Transfer Attributes (DMA_TCD3_ATTR)	16	R/W	Undefined	13.3.24/228
4000_9068	TCD Minor Byte Count (Minor Loop Mapping Disabled) (DMA_TCD3_NBYTES_MLNO)	32	R/W	Undefined	13.3.25/229
4000_9068	TCD Signed Minor Loop Offset (Minor Loop Mapping Enabled and Offset Disabled) (DMA_TCD3_NBYTES_MLOFFNO)	32	R/W	Undefined	13.3.26/229
4000_9068	TCD Signed Minor Loop Offset (Minor Loop Mapping and Offset Enabled) (DMA_TCD3_NBYTES_MLOFFYES)	32	R/W	Undefined	13.3.27/231
4000_906C	TCD Last Source Address Adjustment (DMA_TCD3_SLAST)	32	R/W	Undefined	13.3.28/232
4000_9070	TCD Destination Address (DMA_TCD3_DADDR)	32	R/W	Undefined	13.3.29/232
4000_9074	TCD Signed Destination Address Offset (DMA_TCD3_DOFF)	16	R/W	Undefined	13.3.30/233
4000_9076	TCD Current Minor Loop Link, Major Loop Count (Channel Linking Enabled) (DMA_TCD3_CITER_ELINKYES)	16	R/W	Undefined	13.3.31/233
4000_9076	DMA_TCD3_CITER_ELINKNO	16	R/W	Undefined	13.3.32/235
4000_9078	TCD Last Destination Address Adjustment/Scatter Gather Address (DMA_TCD3_DLASTSGA)	32	R/W	Undefined	13.3.33/236

Table continues on the next page...

Memory map/register definition

DMA memory map (continued)

Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page
4000_907C	TCD Control and Status (DMA_TCD3_CSR)	16	R/W	Undefined	13.3.34/236
4000_907E	TCD Beginning Minor Loop Link, Major Loop Count (Channel Linking Enabled) (DMA_TCD3_BITER_ELINKYES)	16	R/W	Undefined	13.3.35/239
4000_907E	TCD Beginning Minor Loop Link, Major Loop Count (Channel Linking Disabled) (DMA_TCD3_BITER_ELINKNO)	16	R/W	Undefined	13.3.36/240
4000_9080	TCD Source Address (DMA_TCD4_SADDR)	32	R/W	Undefined	13.3.22/227
4000_9084	TCD Signed Source Address Offset (DMA_TCD4_SOFF)	16	R/W	Undefined	13.3.23/227
4000_9086	TCD Transfer Attributes (DMA_TCD4_ATTR)	16	R/W	Undefined	13.3.24/228
4000_9088	TCD Minor Byte Count (Minor Loop Mapping Disabled) (DMA_TCD4_NBYTES_MLNO)	32	R/W	Undefined	13.3.25/229
4000_9088	TCD Signed Minor Loop Offset (Minor Loop Mapping Enabled and Offset Disabled) (DMA_TCD4_NBYTES_MLOFFNO)	32	R/W	Undefined	13.3.26/229
4000_9088	TCD Signed Minor Loop Offset (Minor Loop Mapping and Offset Enabled) (DMA_TCD4_NBYTES_MLOFFYES)	32	R/W	Undefined	13.3.27/231
4000_908C	TCD Last Source Address Adjustment (DMA_TCD4_SLAST)	32	R/W	Undefined	13.3.28/232
4000_9090	TCD Destination Address (DMA_TCD4_DADDR)	32	R/W	Undefined	13.3.29/232
4000_9094	TCD Signed Destination Address Offset (DMA_TCD4_DOFF)	16	R/W	Undefined	13.3.30/233
4000_9096	TCD Current Minor Loop Link, Major Loop Count (Channel Linking Enabled) (DMA_TCD4_CITER_ELINKYES)	16	R/W	Undefined	13.3.31/233
4000_9096	DMA_TCD4_CITER_ELINKNO	16	R/W	Undefined	13.3.32/235
4000_9098	TCD Last Destination Address Adjustment/Scatter Gather Address (DMA_TCD4_DLASTSGA)	32	R/W	Undefined	13.3.33/236
4000_909C	TCD Control and Status (DMA_TCD4_CSR)	16	R/W	Undefined	13.3.34/236
4000_909E	TCD Beginning Minor Loop Link, Major Loop Count (Channel Linking Enabled) (DMA_TCD4_BITER_ELINKYES)	16	R/W	Undefined	13.3.35/239
4000_909E	TCD Beginning Minor Loop Link, Major Loop Count (Channel Linking Disabled) (DMA_TCD4_BITER_ELINKNO)	16	R/W	Undefined	13.3.36/240
4000_90A0	TCD Source Address (DMA_TCD5_SADDR)	32	R/W	Undefined	13.3.22/227
4000_90A4	TCD Signed Source Address Offset (DMA_TCD5_SOFF)	16	R/W	Undefined	13.3.23/227
4000_90A6	TCD Transfer Attributes (DMA_TCD5_ATTR)	16	R/W	Undefined	13.3.24/228
4000_90A8	TCD Minor Byte Count (Minor Loop Mapping Disabled) (DMA_TCD5_NBYTES_MLNO)	32	R/W	Undefined	13.3.25/229
4000_90A8	TCD Signed Minor Loop Offset (Minor Loop Mapping Enabled and Offset Disabled) (DMA_TCD5_NBYTES_MLOFFNO)	32	R/W	Undefined	13.3.26/229
4000_90A8	TCD Signed Minor Loop Offset (Minor Loop Mapping and Offset Enabled) (DMA_TCD5_NBYTES_MLOFFYES)	32	R/W	Undefined	13.3.27/231

Table continues on the next page...

Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page
4000_90AC	TCD Last Source Address Adjustment (DMA_TCD5_SLAST)	32	R/W	Undefined	13.3.28/232
4000_90B0	TCD Destination Address (DMA_TCD5_DADDR)	32	R/W	Undefined	13.3.29/232
4000_90B4	TCD Signed Destination Address Offset (DMA_TCD5_DOFF)	16	R/W	Undefined	13.3.30/233
4000_90B6	TCD Current Minor Loop Link, Major Loop Count (Channel Linking Enabled) (DMA_TCD5_CITER_ELINKYES)	16	R/W	Undefined	13.3.31/233
4000_90B6	DMA_TCD5_CITER_ELINKNO	16	R/W	Undefined	13.3.32/235
4000_90B8	TCD Last Destination Address Adjustment/Scatter Gather Address (DMA_TCD5_DLASTSGA)	32	R/W	Undefined	13.3.33/236
4000_90BC	TCD Control and Status (DMA_TCD5_CSR)	16	R/W	Undefined	13.3.34/236
4000_90BE	TCD Beginning Minor Loop Link, Major Loop Count (Channel Linking Enabled) (DMA_TCD5_BITER_ELINKYES)	16	R/W	Undefined	13.3.35/239
4000_90BE	TCD Beginning Minor Loop Link, Major Loop Count (Channel Linking Disabled) (DMA_TCD5_BITER_ELINKNO)	16	R/W	Undefined	13.3.36/240
4000_90C0	TCD Source Address (DMA_TCD6_SADDR)	32	R/W	Undefined	13.3.22/227
4000_90C4	TCD Signed Source Address Offset (DMA_TCD6_SOFF)	16	R/W	Undefined	13.3.23/227
4000_90C6	TCD Transfer Attributes (DMA_TCD6_ATTR)	16	R/W	Undefined	13.3.24/228
4000_90C8	TCD Minor Byte Count (Minor Loop Mapping Disabled) (DMA_TCD6_NBYTES_MLNO)	32	R/W	Undefined	13.3.25/229
4000_90C8	TCD Signed Minor Loop Offset (Minor Loop Mapping Enabled and Offset Disabled) (DMA_TCD6_NBYTES_MLOFFNO)	32	R/W	Undefined	13.3.26/229
4000_90C8	TCD Signed Minor Loop Offset (Minor Loop Mapping and Offset Enabled) (DMA_TCD6_NBYTES_MLOFFYES)	32	R/W	Undefined	13.3.27/231
4000_90CC	TCD Last Source Address Adjustment (DMA_TCD6_SLAST)	32	R/W	Undefined	13.3.28/232
4000_90D0	TCD Destination Address (DMA_TCD6_DADDR)	32	R/W	Undefined	13.3.29/232
4000_90D4	TCD Signed Destination Address Offset (DMA_TCD6_DOFF)	16	R/W	Undefined	13.3.30/233
4000_90D6	TCD Current Minor Loop Link, Major Loop Count (Channel Linking Enabled) (DMA_TCD6_CITER_ELINKYES)	16	R/W	Undefined	13.3.31/233
4000_90D6	DMA_TCD6_CITER_ELINKNO	16	R/W	Undefined	13.3.32/235
4000_90D8	TCD Last Destination Address Adjustment/Scatter Gather Address (DMA_TCD6_DLASTSGA)	32	R/W	Undefined	13.3.33/236
4000_90DC	TCD Control and Status (DMA_TCD6_CSR)	16	R/W	Undefined	13.3.34/236
4000_90DE	TCD Beginning Minor Loop Link, Major Loop Count (Channel Linking Enabled) (DMA_TCD6_BITER_ELINKYES)	16	R/W	Undefined	13.3.35/239
4000_90DE	TCD Beginning Minor Loop Link, Major Loop Count (Channel Linking Disabled) (DMA_TCD6_BITER_ELINKNO)	16	R/W	Undefined	13.3.36/240
4000_90E0	TCD Source Address (DMA_TCD7_SADDR)	32	R/W	Undefined	13.3.22/227

Table continues on the next page...

Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page
4000_90E4	TCD Signed Source Address Offset (DMA_TCD7_SOFF)	16	R/W	Undefined	13.3.23/227
4000_90E6	TCD Transfer Attributes (DMA_TCD7_ATTR)	16	R/W	Undefined	13.3.24/228
4000_90E8	TCD Minor Byte Count (Minor Loop Mapping Disabled) (DMA_TCD7_NBYTES_MLNO)	32	R/W	Undefined	13.3.25/229
4000_90E8	TCD Signed Minor Loop Offset (Minor Loop Mapping Enabled and Offset Disabled) (DMA_TCD7_NBYTES_MLOFFNO)	32	R/W	Undefined	13.3.26/229
4000_90E8	TCD Signed Minor Loop Offset (Minor Loop Mapping and Offset Enabled) (DMA_TCD7_NBYTES_MLOFFYES)	32	R/W	Undefined	13.3.27/231
4000_90EC	TCD Last Source Address Adjustment (DMA_TCD7_SLAST)	32	R/W	Undefined	13.3.28/232
4000_90F0	TCD Destination Address (DMA_TCD7_DADDR)	32	R/W	Undefined	13.3.29/232
4000_90F4	TCD Signed Destination Address Offset (DMA_TCD7_DOFF)	16	R/W	Undefined	13.3.30/233
4000_90F6	TCD Current Minor Loop Link, Major Loop Count (Channel Linking Enabled) (DMA_TCD7_CITER_ELINKYES)	16	R/W	Undefined	13.3.31/233
4000_90F6	DMA_TCD7_CITER_ELINKNO	16	R/W	Undefined	13.3.32/235
4000_90F8	TCD Last Destination Address Adjustment/Scatter Gather Address (DMA_TCD7_DLASTSGA)	32	R/W	Undefined	13.3.33/236
4000_90FC	TCD Control and Status (DMA_TCD7_CSR)	16	R/W	Undefined	13.3.34/236
4000_90FE	TCD Beginning Minor Loop Link, Major Loop Count (Channel Linking Enabled) (DMA_TCD7_BITER_ELINKYES)	16	R/W	Undefined	13.3.35/239
4000_90FE	TCD Beginning Minor Loop Link, Major Loop Count (Channel Linking Disabled) (DMA_TCD7_BITER_ELINKNO)	16	R/W	Undefined	13.3.36/240

13.3.5 Control Register (DMA_CR)

The CR defines the basic operating configuration of the DMA.

Arbitration can be configured to use either a fixed-priority or a round-robin scheme. For fixed-priority arbitration, the highest priority channel requesting service is selected to execute. The channel priority registers assign the priorities; see the DCHPRIn registers. For round-robin arbitration, the channel priorities are ignored and channels are cycled through (from high to low channel number) without regard to priority.

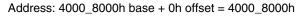
NOTE

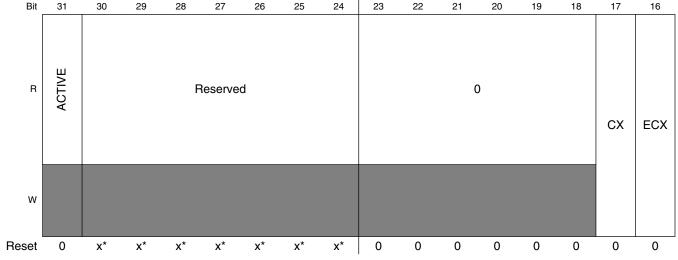
For correct operation, writes to the CR register must be performed only when the DMA channels are inactive; that is, when TCDn_CSR[ACTIVE] bits are cleared.

Minor loop offsets are address offset values added to the final source address (TCDn_SADDR) or destination address (TCDn_DADDR) upon minor loop completion. When minor loop offsets are enabled, the minor loop offset (MLOFF) is added to the final source address (TCDn_SADDR), to the final destination address (TCDn_DADDR), or to both prior to the addresses being written back into the TCD. If the major loop is complete, the minor loop offset is ignored and the major loop address offsets (TCDn_SLAST and TCDn_DLAST_SGA) are used to compute the next TCDn_SADDR and TCDn_DADDR values.

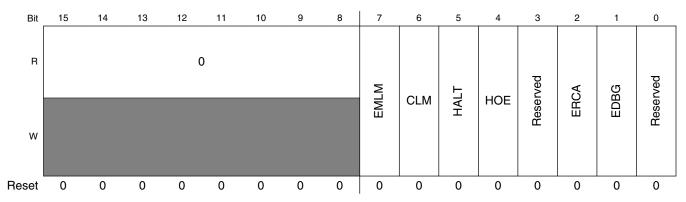
When minor loop mapping is enabled (EMLM is 1), TCDn word2 is redefined. A portion of TCDn word2 is used to specify multiple fields: a source enable bit (SMLOE) to specify the minor loop offset should be applied to the source address (TCDn_SADDR) upon minor loop completion, a destination enable bit (DMLOE) to specify the minor loop offset should be applied to the destination address (TCDn_DADDR) upon minor loop completion, and the sign extended minor loop offset value (MLOFF). The same offset value (MLOFF) is used for both source and destination minor loop offsets. When either minor loop offset is enabled (SMLOE set or DMLOE set), the NBYTES field is reduced to 10 bits. When both minor loop offsets are disabled (SMLOE cleared and DMLOE cleared), the NBYTES field is a 30-bit vector.

When minor loop mapping is disabled (EMLM is 0), all 32 bits of TCDn word2 are assigned to the NBYTES field.





Memory map/register definition



- * Notes:
- x = Undefined at reset.

DMA_CR field descriptions

Field	Description
31 ACTIVE	DMA Active Status
	eDMA is idle. 1 eDMA is executing a channel.
30–24 Reserved	This field is reserved. Reserved
23–18 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
17 CX	Cancel Transfer 0 Normal operation 1 Cancel the remaining data transfer. Stop the executing channel and force the minor loop to finish. The cancel takes effect after the last write of the current read/write sequence. The CX bit clears itself after the cancel has been honored. This cancel retires the channel normally as if the minor loop was completed.
16 ECX	Error Cancel Transfer Normal operation Cancel the remaining data transfer in the same fashion as the CX bit. Stop the executing channel and force the minor loop to finish. The cancel takes effect after the last write of the current read/write sequence. The ECX bit clears itself after the cancel is honored. In addition to cancelling the transfer, ECX treats the cancel as an error condition, thus updating the Error Status register (DMAx_ES) and generating an optional error interrupt.
15–8 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
7 EMLM	 Enable Minor Loop Mapping Disabled. TCDn.word2 is defined as a 32-bit NBYTES field. Enabled. TCDn.word2 is redefined to include individual enable fields, an offset field, and the NBYTES field. The individual enable fields allow the minor loop offset to be applied to the source address, the destination address, or both. The NBYTES field is reduced when either offset is enabled.
6 CLM	Continuous Link Mode

Table continues on the next page...

DMA_CR field descriptions (continued)

Field	Description
	NOTE: Do not use continuous link mode with a channel linking to itself if there is only one minor loop iteration per service request, e.g., if the channel's NBYTES value is the same as either the source or destination size. The same data transfer profile can be achieved by simply increasing the NBYTES value, which provides more efficient, faster processing.
	 A minor loop channel link made to itself goes through channel arbitration before being activated again. A minor loop channel link made to itself does not go through channel arbitration before being activated again. Upon minor loop completion, the channel activates again if that channel has a minor loop channel link enabled and the link channel is itself. This effectively applies the minor loop offsets and restarts the next minor loop.
5 HALT	Halt DMA Operations
HALI	 Normal operation Stall the start of any new channels. Executing channels are allowed to complete. Channel execution resumes when this bit is cleared.
4 HOE	Halt On Error
TIOE	 Normal operation Any error causes the HALT bit to set. Subsequently, all service requests are ignored until the HALT bit is cleared.
3 Reserved	This field is reserved. Reserved
2 ERCA	Enable Round Robin Channel Arbitration
LITOA	 Fixed priority arbitration is used for channel selection . Round robin arbitration is used for channel selection .
1 EDBG	Enable Debug
	 When in debug mode, the DMA continues to operate. When in debug mode, the DMA stalls the start of a new channel. Executing channels are allowed to complete. Channel execution resumes when the system exits debug mode or the EDBG bit is cleared.
0 Reserved	This field is reserved. Reserved

13.3.6 Error Status Register (DMA_ES)

The ES provides information concerning the last recorded channel error. Channel errors can be caused by:

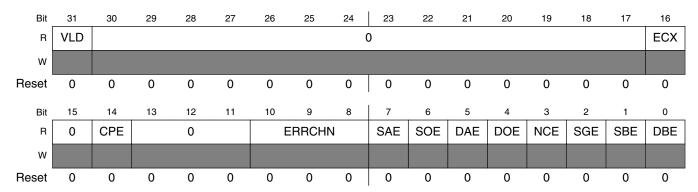
- A configuration error, that is:
 - An illegal setting in the transfer-control descriptor, or
 - An illegal priority register setting in fixed-arbitration
- An error termination to a bus master read or write cycle
- A cancel transfer with error bit that will be set when a transfer is canceled via the corresponding cancel transfer control bit

See Fault reporting and handling for more details.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Memory map/register definition

Address: 4000_8000h base + 4h offset = 4000_8004h



DMA_ES field descriptions

Field	Description
31 VLD	Logical OR of all ERR status bits O No ERR bits are set. At least one ERR bit is set indicating a valid error exists that has not been cleared.
30–17 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
16 ECX	Transfer Canceled O No canceled transfers The last recorded entry was a canceled transfer by the error cancel transfer input
15 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
14 CPE	Channel Priority Error No channel priority error The last recorded error was a configuration error in the channel priorities . Channel priorities are not unique.
13–11 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
10-8 ERRCHN	Error Channel Number or Canceled Channel Number The channel number of the last recorded error, excluding CPE errors, or last recorded error canceled transfer.
7 SAE	Source Address Error 0 No source address configuration error. 1 The last recorded error was a configuration error detected in the TCDn_SADDR field. TCDn_SADDR is inconsistent with TCDn_ATTR[SSIZE].
6 SOE	Source Offset Error 0 No source offset configuration error 1 The last recorded error was a configuration error detected in the TCDn_SOFF field. TCDn_SOFF is inconsistent with TCDn_ATTR[SSIZE].
5 DAE	Destination Address Error

Table continues on the next page...

DMA_ES field descriptions (continued)

Field	Description
	0 No destination address configuration error
	1 The last recorded error was a configuration error detected in the TCDn_DADDR field. TCDn_DADDR is inconsistent with TCDn_ATTR[DSIZE].
4 DOE	Destination Offset Error
	0 No destination offset configuration error
	1 The last recorded error was a configuration error detected in the TCDn_DOFF field. TCDn_DOFF is inconsistent with TCDn_ATTR[DSIZE].
3 NCE	NBYTES/CITER Configuration Error
	0 No NBYTES/CITER configuration error
	1 The last recorded error was a configuration error detected in the TCDn_NBYTES or TCDn_CITER fields.
	 TCDn_NBYTES is not a multiple of TCDn_ATTR[SSIZE] and TCDn_ATTR[DSIZE], or TCDn_CITER[CITER] is equal to zero, or
	TCDn_CITER[CITER] is equal to Zero, or TCDn_CITER[ELINK] is not equal to TCDn_BITER[ELINK]
2 SGE	Scatter/Gather Configuration Error
	0 No scatter/gather configuration error
	1 The last recorded error was a configuration error detected in the TCDn_DLASTSGA field. This field is checked at the beginning of a scatter/gather operation after major loop completion if TCDn_CSR[ESG] is enabled. TCDn_DLASTSGA is not on a 32 byte boundary.
1 SBE	Source Bus Error
	0 No source bus error
	1 The last recorded error was a bus error on a source read
0 DBE	Destination Bus Error
	0 No destination bus error
	1 The last recorded error was a bus error on a destination write

13.3.7 Enable Request Register (DMA_ERQ)

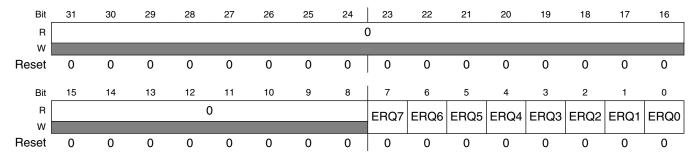
The ERQ register provides a bit map for the 8 channels to enable the request signal for each channel. The state of any given channel enable is directly affected by writes to this register; it is also affected by writes to the SERQ and CERQ registers. These registers are provided so the request enable for a single channel can easily be modified without needing to perform a read-modify-write sequence to the ERQ.

DMA request input signals and this enable request flag must be asserted before a channel's hardware service request is accepted. The state of the DMA enable request flag does not affect a channel service request made explicitly through software or a linked channel request.

NOTE

Disable a channel's hardware service request at the source before clearing the channel's ERQ bit.

Address: 4000_8000h base + Ch offset = 4000_800Ch



DMA_ERQ field descriptions

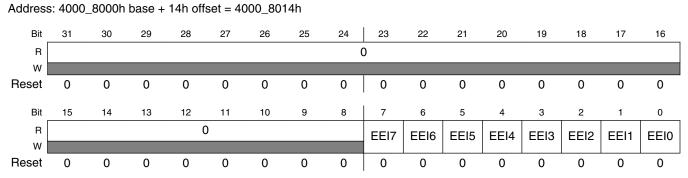
Field	Description
31–8 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
7 ERQ7	Enable DMA Request 7
	 The DMA request signal for the corresponding channel is disabled The DMA request signal for the corresponding channel is enabled
6 ERQ6	Enable DMA Request 6
	0 The DMA request signal for the corresponding channel is disabled
	1 The DMA request signal for the corresponding channel is enabled
5 ERQ5	Enable DMA Request 5
	0 The DMA request signal for the corresponding channel is disabled
	1 The DMA request signal for the corresponding channel is enabled
4 ERQ4	Enable DMA Request 4
	O The DMA request signal for the corresponding channel is disabled
	1 The DMA request signal for the corresponding channel is enabled
3 ERQ3	Enable DMA Request 3
Engo	0 The DMA request signal for the corresponding channel is disabled
	1 The DMA request signal for the corresponding channel is enabled
2 ERQ2	Enable DMA Request 2
	0 The DMA request signal for the corresponding channel is disabled
	1 The DMA request signal for the corresponding channel is enabled
1 ERQ1	Enable DMA Request 1
	0 The DMA request signal for the corresponding channel is disabled
	1 The DMA request signal for the corresponding channel is enabled
0 ERQ0	Enable DMA Request 0
	0 The DMA request signal for the corresponding channel is disabled
	1 The DMA request signal for the corresponding channel is enabled

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

13.3.8 Enable Error Interrupt Register (DMA_EEI)

The EEI register provides a bit map for the 8 channels to enable the error interrupt signal for each channel. The state of any given channel's error interrupt enable is directly affected by writes to this register; it is also affected by writes to the SEEI and CEEI. These registers are provided so that the error interrupt enable for a single channel can easily be modified without the need to perform a read-modify-write sequence to the EEI register.

The DMA error indicator and the error interrupt enable flag must be asserted before an error interrupt request for a given channel is asserted to the interrupt controller.



DMA EEI field descriptions

Field	Description
31–8	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
7 EEI7	Enable Error Interrupt 7
	0 The error signal for corresponding channel does not generate an error interrupt
	1 The assertion of the error signal for corresponding channel generates an error interrupt request
6 EEI6	Enable Error Interrupt 6
	0 The error signal for corresponding channel does not generate an error interrupt
	1 The assertion of the error signal for corresponding channel generates an error interrupt request
5 EEI5	Enable Error Interrupt 5
	0 The error signal for corresponding channel does not generate an error interrupt
	1 The assertion of the error signal for corresponding channel generates an error interrupt request
4 EEI4	Enable Error Interrupt 4
	0 The error signal for corresponding channel does not generate an error interrupt
	1 The assertion of the error signal for corresponding channel generates an error interrupt request
3 EEI3	Enable Error Interrupt 3
	0 The error signal for corresponding channel does not generate an error interrupt
	1 The assertion of the error signal for corresponding channel generates an error interrupt request

Table continues on the next page...

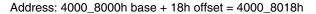
Memory map/register definition

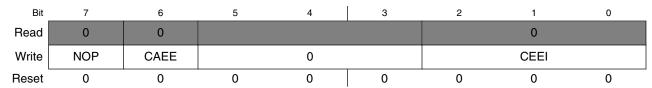
DMA_EEI field descriptions (continued)

Field	Description
2 EEI2	Enable Error Interrupt 2
	0 The error signal for corresponding channel does not generate an error interrupt
	1 The assertion of the error signal for corresponding channel generates an error interrupt request
1 EEI1	Enable Error Interrupt 1
	0 The error signal for corresponding channel does not generate an error interrupt
	1 The assertion of the error signal for corresponding channel generates an error interrupt request
0 EEI0	Enable Error Interrupt 0
	0 The error signal for corresponding channel does not generate an error interrupt
	1 The assertion of the error signal for corresponding channel generates an error interrupt request

13.3.9 Clear Enable Error Interrupt Register (DMA_CEEI)

The CEEI provides a simple memory-mapped mechanism to clear a given bit in the EEI to disable the error interrupt for a given channel. The data value on a register write causes the corresponding bit in the EEI to be cleared. Setting the CAEE bit provides a global clear function, forcing the EEI contents to be cleared, disabling all DMA request inputs. If the NOP bit is set, the command is ignored. This allows you to write multiple-byte registers as a 32-bit word. Reads of this register return all zeroes.





DMA_CEEI field descriptions

Field	Description
7	No Op enable
NOP	O. Named as anti-m
	0 Normal operation
	1 No operation, ignore the other bits in this register
6	Clear All Enable Error Interrupts
CAEE	
	0 Clear only the EEI bit specified in the CEEI field
	1 Clear all bits in EEI
5–3	This field is reserved.
Reserved	

Table continues on the next page...

DMA_CEEI field descriptions (continued)

Field	Description
CEEI	Clear Enable Error Interrupt
	Clears the corresponding bit in EEI

13.3.10 Set Enable Error Interrupt Register (DMA_SEEI)

The SEEI provides a simple memory-mapped mechanism to set a given bit in the EEI to enable the error interrupt for a given channel. The data value on a register write causes the corresponding bit in the EEI to be set. Setting the SAEE bit provides a global set function, forcing the entire EEI contents to be set. If the NOP bit is set, the command is ignored. This allows you to write multiple-byte registers as a 32-bit word. Reads of this register return all zeroes.

Address: 4000_8000h base + 19h offset = 4000_8019h



DMA_SEEI field descriptions

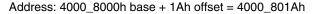
Field	Description
7 NOP	No Op enable
	0 Normal operation
	1 No operation, ignore the other bits in this register
6 SAEE	Sets All Enable Error Interrupts
	0 Set only the EEI bit specified in the SEEI field.
	1 Sets all bits in EEI
5–3 Reserved	This field is reserved.
SEEI	Set Enable Error Interrupt
	Sets the corresponding bit in EEI

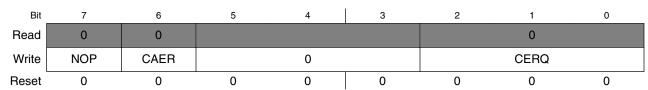
13.3.11 Clear Enable Request Register (DMA_CERQ)

The CERQ provides a simple memory-mapped mechanism to clear a given bit in the ERQ to disable the DMA request for a given channel. The data value on a register write causes the corresponding bit in the ERQ to be cleared. Setting the CAER bit provides a global clear function, forcing the entire contents of the ERQ to be cleared, disabling all DMA request inputs. If NOP is set, the command is ignored. This allows you to write multiple-byte registers as a 32-bit word. Reads of this register return all zeroes.

NOTE

Disable a channel's hardware service request at the source before clearing the channel's ERQ bit.



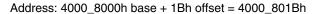


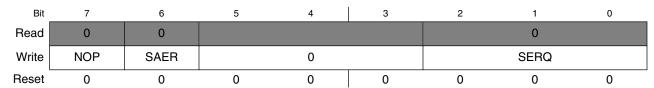
DMA_CERQ field descriptions

Field	Description
7 NOP	No Op enable
	0 Normal operation
	1 No operation, ignore the other bits in this register
6 CAER	Clear All Enable Requests
	0 Clear only the ERQ bit specified in the CERQ field
	1 Clear all bits in ERQ
5–3	This field is reserved.
Reserved	
CERQ	Clear Enable Request
	Clears the corresponding bit in ERQ.

13.3.12 Set Enable Request Register (DMA_SERQ)

The SERQ provides a simple memory-mapped mechanism to set a given bit in the ERQ to enable the DMA request for a given channel. The data value on a register write causes the corresponding bit in the ERQ to be set. Setting the SAER bit provides a global set function, forcing the entire contents of ERQ to be set. If the NOP bit is set, the command is ignored. This allows you to write multiple-byte registers as a 32-bit word. Reads of this register return all zeroes.





DMA_SERQ field descriptions

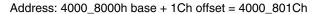
Field	Description
7	No Op enable
NOP	
	0 Normal operation
	1 No operation, ignore the other bits in this register
6	Set All Enable Requests
SAER	
	0 Set only the ERQ bit specified in the SERQ field
	1 Set all bits in ERQ
5–3	This field is reserved.
Reserved	
SERQ	Set Enable Request
	Sets the corresponding bit in ERQ.

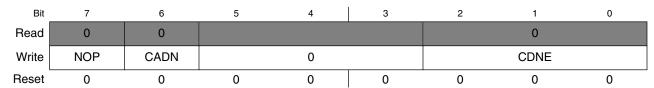
Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

215

13.3.13 Clear DONE Status Bit Register (DMA_CDNE)

The CDNE provides a simple memory-mapped mechanism to clear the DONE bit in the TCD of the given channel. The data value on a register write causes the DONE bit in the corresponding transfer control descriptor to be cleared. Setting the CADN bit provides a global clear function, forcing all DONE bits to be cleared. If the NOP bit is set, the command is ignored. This allows you to write multiple-byte registers as a 32-bit word. Reads of this register return all zeroes.





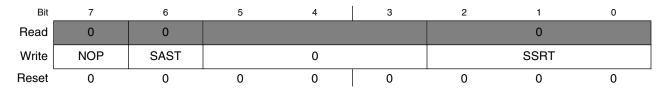
DMA_CDNE field descriptions

Field	Description
7	No Op enable
NOP	
	0 Normal operation
	1 No operation, ignore the other bits in this register
6	Clears All DONE Bits
CADN	
	0 Clears only the TCDn_CSR[DONE] bit specified in the CDNE field
	1 Clears all bits in TCDn_CSR[DONE]
5–3	This field is reserved.
Reserved	
CDNE	Clear DONE Bit
	Clears the corresponding bit in TCDn_CSR[DONE]

13.3.14 Set START Bit Register (DMA_SSRT)

The SSRT provides a simple memory-mapped mechanism to set the START bit in the TCD of the given channel. The data value on a register write causes the START bit in the corresponding transfer control descriptor to be set. Setting the SAST bit provides a global set function, forcing all START bits to be set. If the NOP bit is set, the command is ignored. This allows you to write multiple-byte registers as a 32-bit word. Reads of this register return all zeroes.

Address: 4000_8000h base + 1Dh offset = 4000_801Dh



DMA_SSRT field descriptions

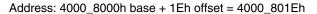
Field	Description										
7	No Op enable										
NOP											
	0 Normal operation										
	No operation, ignore the other bits in this register										
6	Set All START Bits (activates all channels)										
SAST											
	0 Set only the TCDn_CSR[START] bit specified in the SSRT field										
	Set all bits in TCDn_CSR[START]										
5–3	This field is reserved.										
Reserved											
SSRT	Set START Bit										
	Sets the corresponding bit in TCDn_CSR[START]										

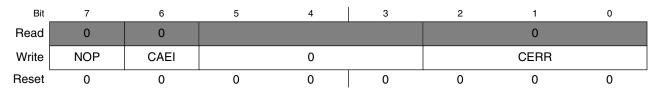
NXP Semiconductors

217

13.3.15 Clear Error Register (DMA_CERR)

The CERR provides a simple memory-mapped mechanism to clear a given bit in the ERR to disable the error condition flag for a given channel. The given value on a register write causes the corresponding bit in the ERR to be cleared. Setting the CAEI bit provides a global clear function, forcing the ERR contents to be cleared, clearing all channel error indicators. If the NOP bit is set, the command is ignored. This allows you to write multiple-byte registers as a 32-bit word. Reads of this register return all zeroes.



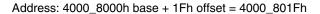


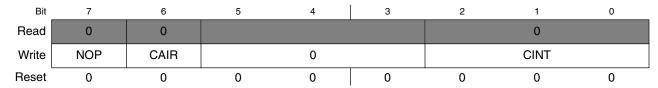
DMA_CERR field descriptions

Field	Description								
7 NOP	No Op enable								
	0 Normal operation								
	1 No operation, ignore the other bits in this register								
6	Clear All Error Indicators								
CAEI	0 Clear only the ERR bit specified in the CERR field								
	1 Clear all bits in ERR								
5–3 Reserved	This field is reserved.								
CERR	Clear Error Indicator								
	Clears the corresponding bit in ERR								

13.3.16 Clear Interrupt Request Register (DMA_CINT)

The CINT provides a simple, memory-mapped mechanism to clear a given bit in the INT to disable the interrupt request for a given channel. The given value on a register write causes the corresponding bit in the INT to be cleared. Setting the CAIR bit provides a global clear function, forcing the entire contents of the INT to be cleared, disabling all DMA interrupt requests. If the NOP bit is set, the command is ignored. This allows you to write multiple-byte registers as a 32-bit word. Reads of this register return all zeroes.





DMA_CINT field descriptions

Field	Description
7	No Op enable
NOP	0 Normal operation
	·
6	Clear All Interrupt Requests
CAIR	0 Clear only the INT bit specified in the CINT field
	1 Clear all bits in INT
5–3	This field is reserved.
Reserved	
CINT	Clear Interrupt Request
	Clears the corresponding bit in INT

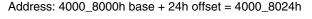
NXP Semiconductors

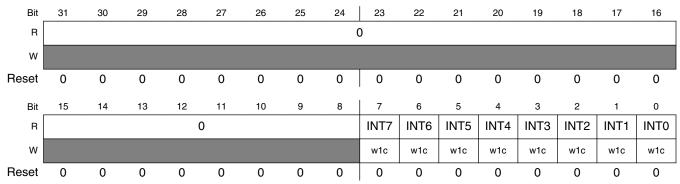
219

Interrupt Request Register (DMA INT) 13.3.17

The INT register provides a bit map for the 8 channels signaling the presence of an interrupt request for each channel. Depending on the appropriate bit setting in the transfer-control descriptors, the eDMA engine generates an interrupt on data transfer completion. The outputs of this register are directly routed to the interrupt controller. During the interrupt-service routine associated with any given channel, it is the software's responsibility to clear the appropriate bit, negating the interrupt request. Typically, a write to the CINT register in the interrupt service routine is used for this purpose.

The state of any given channel's interrupt request is directly affected by writes to this register; it is also affected by writes to the CINT register. On writes to INT, a 1 in any bit position clears the corresponding channel's interrupt request. A zero in any bit position has no affect on the corresponding channel's current interrupt status. The CINT register is provided so the interrupt request for a single channel can easily be cleared without the need to perform a read-modify-write sequence to the INT register.





DMA_INT field descriptions

Field	Description											
31–8	This field is reserved.											
Reserved	his read-only field is reserved and always has the value 0.											
7	Interrupt Request 7											
INT7												
	The interrupt request for corresponding channel is cleared											
	The interrupt request for corresponding channel is active											
6	Interrupt Request 6											
INT6												
	The interrupt request for corresponding channel is cleared											
	The interrupt request for corresponding channel is active											
5	Interrupt Request 5											
INT5												

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

DMA_INT field descriptions (continued)

Field	Description
	0 The interrupt request for corresponding channel is cleared
	1 The interrupt request for corresponding channel is active
4 INT4	Interrupt Request 4
	0 The interrupt request for corresponding channel is cleared
	1 The interrupt request for corresponding channel is active
3 INT3	Interrupt Request 3
	The interrupt request for corresponding channel is cleared
	1 The interrupt request for corresponding channel is active
2 INT2	Interrupt Request 2
	The interrupt request for corresponding channel is cleared
	1 The interrupt request for corresponding channel is active
1 INT1	Interrupt Request 1
	0 The interrupt request for corresponding channel is cleared
	1 The interrupt request for corresponding channel is active
0 INT0	Interrupt Request 0
	The interrupt request for corresponding channel is cleared
	1 The interrupt request for corresponding channel is active

13.3.18 Error Register (DMA_ERR)

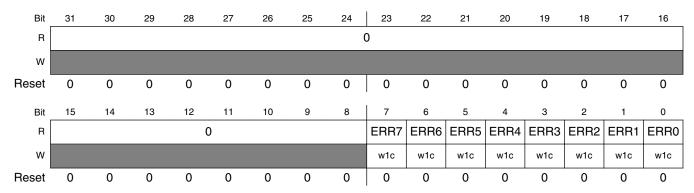
The ERR provides a bit map for the channels, signaling the presence of an error for each channel. The eDMA engine signals the occurrence of an error condition by setting the appropriate bit in this register. The outputs of this register are enabled by the contents of the EEI, and then routed to the interrupt controller. During the execution of the interrupt-service routine associated with any DMA errors, it is software's responsibility to clear the appropriate bit, negating the error-interrupt request. Typically, a write to the CERR in the interrupt-service routine is used for this purpose. The normal DMA channel completion indicators (setting the transfer control descriptor DONE flag and the possible assertion of an interrupt request) are not affected when an error is detected.

The contents of this register can also be polled because a non-zero value indicates the presence of a channel error regardless of the state of the EEI. The state of any given channel's error indicators is affected by writes to this register; it is also affected by writes to the CERR. On writes to the ERR, a one in any bit position clears the corresponding channel's error status. A zero in any bit position has no affect on the corresponding channel's current error status. The CERR is provided so the error indicator for a single channel can easily be cleared.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Memory map/register definition

Address: 4000_8000h base + 2Ch offset = 4000_802Ch



DMA_ERR field descriptions

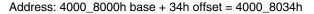
Field	Description
31–8 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
7 ERR7	Error In Channel 7 O An error in this channel has not occurred An error in this channel has occurred
6 ERR6	Error In Channel 6 O An error in this channel has not occurred An error in this channel has occurred
5 ERR5	Error In Channel 5 O An error in this channel has not occurred 1 An error in this channel has occurred
4 ERR4	Error In Channel 4 O An error in this channel has not occurred An error in this channel has occurred
3 ERR3	Error In Channel 3 O An error in this channel has not occurred 1 An error in this channel has occurred
2 ERR2	Error In Channel 2 O An error in this channel has not occurred An error in this channel has occurred
1 ERR1	Error In Channel 1 O An error in this channel has not occurred An error in this channel has occurred
0 ERR0	Error In Channel 0 O An error in this channel has not occurred An error in this channel has occurred

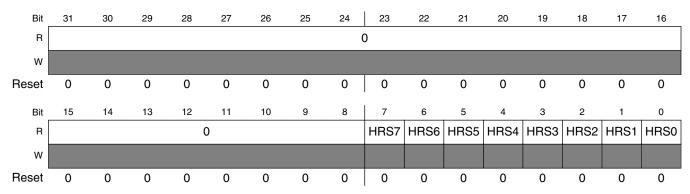
13.3.19 Hardware Request Status Register (DMA_HRS)

The HRS register provides a bit map for the DMA channels, signaling the presence of a hardware request for each channel. The hardware request status bits reflect the current state of the register and qualified (via the ERQ fields) DMA request signals as seen by the DMA's arbitration logic. This view into the hardware request signals may be used for debug purposes.

NOTE

These bits reflect the state of the request as seen by the arbitration logic. Therefore, this status is affected by the ERQ bits.





DMA_HRS field descriptions

Field	Description											
31–8	This field is reserved.											
Reserved	his read-only field is reserved and always has the value 0.											
7 HRS7	Hardware Request Status Channel 7											
	The HRS bit for its respective channel remains asserted for the period when a Hardware Request is Present on the Channel. After the Request is completed and Channel is free, the HRS bit is automatically cleared by hardware.											
	0 A hardware service request for channel 7 is not present											
	1 A hardware service request for channel 7 is present											
6 HRS6	Hardware Request Status Channel 6											
	The HRS bit for its respective channel remains asserted for the period when a Hardware Request is Present on the Channel. After the Request is completed and Channel is free, the HRS bit is automatically cleared by hardware.											
	0 A hardware service request for channel 6 is not present											
	1 A hardware service request for channel 6 is present											
5 HRS5	Hardware Request Status Channel 5											

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

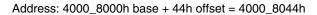
Memory map/register definition

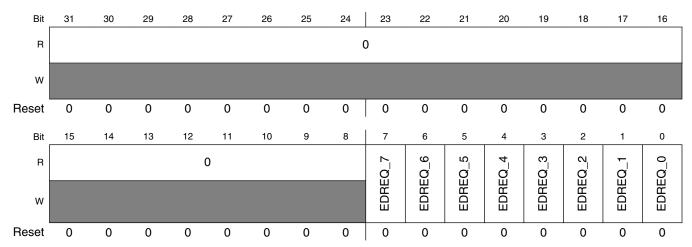
DMA_HRS field descriptions (continued)

Field	Description										
	The HRS bit for its respective channel remains asserted for the period when a Hardware Request is Present on the Channel. After the Request is completed and Channel is free, the HRS bit is automatically cleared by hardware.										
	0 A hardware service request for channel 5 is not present										
	1 A hardware service request for channel 5 is present										
4 HRS4	Hardware Request Status Channel 4										
	The HRS bit for its respective channel remains asserted for the period when a Hardware Request is Present on the Channel. After the Request is completed and Channel is free, the HRS bit is automatically cleared by hardware.										
	0 A hardware service request for channel 4 is not present										
	1 A hardware service request for channel 4 is present										
3 HRS3	Hardware Request Status Channel 3										
	The HRS bit for its respective channel remains asserted for the period when a Hardware Request is Present on the Channel. After the Request is completed and Channel is free, the HRS bit is automatically cleared by hardware.										
	0 A hardware service request for channel 3 is not present										
	1 A hardware service request for channel 3 is present										
2 HRS2	Hardware Request Status Channel 2										
	The HRS bit for its respective channel remains asserted for the period when a Hardware Request is Present on the Channel. After the Request is completed and Channel is free, the HRS bit is automatically cleared by hardware.										
	0 A hardware service request for channel 2 is not present										
	1 A hardware service request for channel 2 is present										
1 HRS1	Hardware Request Status Channel 1										
	The HRS bit for its respective channel remains asserted for the period when a Hardware Request is Present on the Channel. After the Request is completed and Channel is free, the HRS bit is automatically cleared by hardware.										
	0 A hardware service request for channel 1 is not present										
	1 A hardware service request for channel 1 is present										
0 HRS0	Hardware Request Status Channel 0										
	The HRS bit for its respective channel remains asserted for the period when a Hardware Request is Present on the Channel. After the Request is completed and Channel is free, the HRS bit is automatically cleared by hardware.										
	0 A hardware service request for channel 0 is not present										
	1 A hardware service request for channel 0 is present										

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

13.3.20 Enable Asynchronous Request in Stop Register (DMA_EARS)





DMA_EARS field descriptions

Field	Description
31–8	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
7 EDREQ_7	Enable asynchronous DMA request in stop mode for channel 7
_	0 Disable asynchronous DMA request for channel 7.
	1 Enable asynchronous DMA request for channel 7.
6 EDREQ_6	Enable asynchronous DMA request in stop mode for channel 6
	0 Disable asynchronous DMA request for channel 6.
	1 Enable asynchronous DMA request for channel 6.
5 EDREQ_5	Enable asynchronous DMA request in stop mode for channel 5
	0 Disable asynchronous DMA request for channel 5.
	1 Enable asynchronous DMA request for channel 5.
4 EDREQ_4	Enable asynchronous DMA request in stop mode for channel 4
	0 Disable asynchronous DMA request for channel 4.
	1 Enable asynchronous DMA request for channel 4.
3 EDREQ_3	Enable asynchronous DMA request in stop mode for channel 3.
	0 Disable asynchronous DMA request for channel 3.
	1 Enable asynchronous DMA request for channel 3.
2 EDREQ_2	Enable asynchronous DMA request in stop mode for channel 2.
	0 Disable asynchronous DMA request for channel 2.
	1 Enable asynchronous DMA request for channel 2.
1 EDREQ_1	Enable asynchronous DMA request in stop mode for channel 1.

Table continues on the next page...

Memory map/register definition

DMA_EARS field descriptions (continued)

Field	Description												
	Disable asynchronous DMA request for channel 1												
	Enable asynchronous DMA request for channel 1.												
0 EDREQ 0	Enable asynchronous DMA request in stop mode for channel 0.												
	0 Disable asynchronous DMA request for channel 0.												
	1 Enable asynchronous DMA request for channel 0.												

13.3.21 Channel n Priority Register (DMA_DCHPRIn)

When fixed-priority channel arbitration is enabled (CR[ERCA] = 0), the contents of these registers define the unique priorities associated with each channel. The channel priorities are evaluated by numeric value; for example, 0 is the lowest priority, 1 is the next higher priority, then 2, 3, etc. Software must program the channel priorities with unique values; otherwise, a configuration error is reported. The range of the priority value is limited to the values of 0 through 7.

Address: 4000_8000h base + 100h offset + $(1d \times i)$, where i=0d to 7d



- * Notes:
- CHPRI field: See bit field description.

DMA_DCHPRIn field descriptions

Field	Description												
7	Enable Channel Preemption.												
ECP	Channel a connet be augusted by a higher priority abannel's convice request												
	O Channel n cannot be suspended by a higher priority channel's service request.												
	Channel n can be temporarily suspended by the service request of a higher priority channel.												
6	Disable Preempt Ability.												
DPA													
	O Channel n can suspend a lower priority channel.												
	Channel n cannot suspend any channel, regardless of channel priority.												
5–3	This field is reserved.												
Reserved	This read-only field is reserved and always has the value 0.												
CHPRI	Channel n Arbitration Priority												
	Channel priority when fixed-priority arbitration is enabled												
	NOTE: Reset value for the channel priority field, CHPRI, is equal to the corresponding channel number for each priority register, that is, DCHPRI7[CHPRI] = 0b111.												

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

13.3.22 TCD Source Address (DMA_TCDn_SADDR)

Address: 4000_8000h base + 1000h offset + $(32d \times i)$, where i=0d to 7d

Bit	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
R																SAF	DB										•					
W	SADDR																															
Reset	v*	v *	v*	v*	v *	v*	v *																									

^{*} Notes:

DMA_TCDn_SADDR field descriptions

Field	Description
SADDR	Source Address
	Memory address pointing to the source data.

13.3.23 TCD Signed Source Address Offset (DMA_TCDn_SOFF)

Address: 4000_8000h base + 1004h offset + $(32d \times i)$, where i=0d to 7d

Bit	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
Read								SC	FF							
Write	5511															
Reset	X *	X *	X *	Χ*	Χ*	Х*	Х*	X *	X*	Х*	X *	Χ*	Х*	Χ*	Х*	X *

^{*} Notes:

DMA_TCDn_SOFF field descriptions

Field	Description
	Source address signed offset Sign-extended offset applied to the current source address to form the next-state value as each source
	read is completed.

NXP Semiconductors

227

x = Undefined at reset.

[•] x = Undefined at reset.

13.3.24 TCD Transfer Attributes (DMA_TCDn_ATTR)

Address: 4000_8000h base + 1006h offset + $(32d \times i)$, where i=0d to 7d

Bit	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
Read Write	SMOD SSIZE					DMOD					DSIZE					
Reset	х*	х*	x *	х*	x*	x *	X *	х*	X*	X *	х*	X *				

^{*} Notes:

DMA_TCDn_ATTR field descriptions

Field	Description									
15–11 SMOD	Source Address Modulo									
	0 Source address modulo feature is disabled									
	≠0 This value defines a specific address range specified to be the value after SADDR + SOFF calculation is performed on the original register value. Setting this field provides the ability to implement a circular data queue easily. For data queues requiring power-of-2 size bytes, the queue should start at a 0-modulo-size address and the SMOD field should be set to the appropriate value for the queue, freezing the desired number of upper address bits. The value programmed into this field specifies the number of lower address bits allowed to change. For a circular queue application, the SOFF is typically set to the transfer size to implement post-increment addressing with the SMOD function constraining the addresses to a 0-modulo-size range.									
10–8 SSIZE	Source data transfer size									
	NOTE: Using a Reserved value causes a configuration error.									
	The eDMA defaults to privileged data access for all transactions.									
	000 8-bit									
	001 16-bit									
	010 32-bit									
	011 Reserved									
	100 16-byte									
	101 32-byte									
	110 Reserved									
	111 Reserved									
7–3 DMOD	Destination Address Modulo See the SMOD definition									
DSIZE	Destination data transfer size									
DSIZE										
	See the SSIZE definition									

[•] x = Undefined at reset.

13.3.25 TCD Minor Byte Count (Minor Loop Mapping Disabled) (DMA_TCDn_NBYTES_MLNO)

This register, or one of the next two registers (TCD_NBYTES_MLOFFNO, TCD_NBYTES_MLOFFYES), defines the number of bytes to transfer per request. Which register to use depends on whether minor loop mapping is disabled, enabled but not used for this channel, or enabled and used.

TCD word 2 is defined as follows if:

• Minor loop mapping is disabled (CR[EMLM] = 0)

If minor loop mapping is enabled, see the TCD_NBYTES_MLOFFNO and TCD_NBYTES_MLOFFYES register descriptions for the definition of TCD word 2.

Address: 4000_8000h base + 1008h offset + (32d × i), where i=0d to 7d

Bit 31 30 29 28 27 26 25 24 23 22 21 20 19 18 17 16 | 15 14 13 12 11 10 9 8 7 6 5 4 3 2 1 0

NBYTES

DMA_TCDn_NBYTES_MLNO field descriptions

Field	Description
NBYTES	Minor Byte Transfer Count
	Number of bytes to be transferred in each service request of the channel. As a channel activates, the appropriate TCD contents load into the eDMA engine, and the appropriate reads and writes perform until the minor byte transfer count has transferred. This is an indivisible operation and cannot be halted. It can, however, be stalled by using the bandwidth control field, or via preemption. After the minor count is exhausted, the SADDR and DADDR values are written back into the TCD memory, the major iteration count is decremented and restored to the TCD memory. If the major iteration count is completed, additional processing is performed. NOTE: An NBYTES value of 0x0000_0000 is interpreted as a 4 GB transfer.

13.3.26 TCD Signed Minor Loop Offset (Minor Loop Mapping Enabled and Offset Disabled) (DMA_TCDn_NBYTES_MLOFFNO)

One of three registers (this register, TCD_NBYTES_MLNO, or TCD_NBYTES_MLOFFYES), defines the number of bytes to transfer per request. Which register to use depends on whether minor loop mapping is disabled, enabled but not used for this channel, or enabled and used.

TCD word 2 is defined as follows if:

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

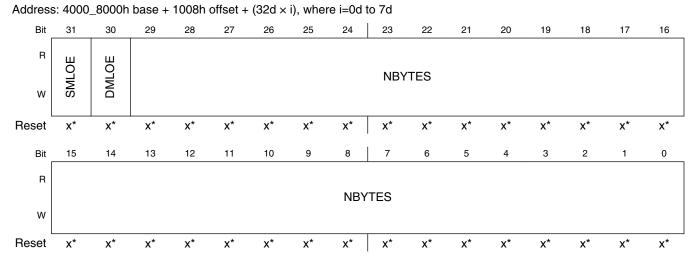
^{*} Notes:

[•] x = Undefined at reset.

Memory map/register definition

- Minor loop mapping is enabled (CR[EMLM] = 1) and
- SMLOE = 0 and DMLOE = 0

If minor loop mapping is enabled and SMLOE or DMLOE is set, then refer to the TCD_NBYTES_MLOFFYES register description. If minor loop mapping is disabled, then refer to the TCD_NBYTES_MLNO register description.



^{*} Notes:

DMA_TCDn_NBYTES_MLOFFNO field descriptions

Field	Description										
31 SMLOE	Source Minor Loop Offset Enable										
	Selects whether the minor loop offset is applied to the source address upon minor loop completion.										
	0 The minor loop offset is not applied to the SADDR										
	1 The minor loop offset is applied to the SADDR										
30 DMLOE	Destination Minor Loop Offset enable										
	Selects whether the minor loop offset is applied to the destination address upon minor loop completion.										
	0 The minor loop offset is not applied to the DADDR										
	1 The minor loop offset is applied to the DADDR										
NBYTES	Minor Byte Transfer Count										
	Number of bytes to be transferred in each service request of the channel.										
	As a channel activates, the appropriate TCD contents load into the eDMA engine, and the appropriate reads and writes perform until the minor byte transfer count has transferred. This is an indivisible operation and cannot be halted. It can, however, be stalled by using the bandwidth control field, or via preemption. After the minor count is exhausted, the SADDR and DADDR values are written back into the TCD memory, the major iteration count is decremented and restored to the TCD memory. If the major iteration count is completed, additional processing is performed.										

x = Undefined at reset.

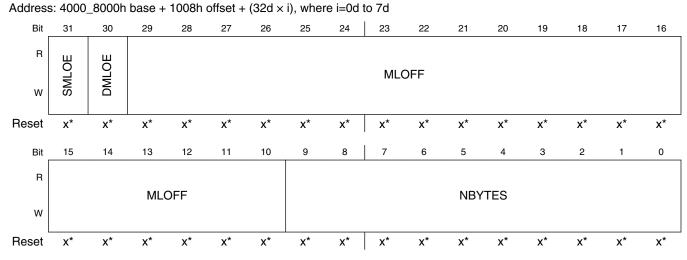
13.3.27 TCD Signed Minor Loop Offset (Minor Loop Mapping and Offset Enabled) (DMA_TCDn_NBYTES_MLOFFYES)

One of three registers (this register, TCD_NBYTES_MLNO, or TCD_NBYTES_MLOFFNO), defines the number of bytes to transfer per request. Which register to use depends on whether minor loop mapping is disabled, enabled but not used for this channel, or enabled and used.

TCD word 2 is defined as follows if:

- Minor loop mapping is enabled (CR[EMLM] = 1) and
- Minor loop offset is enabled (SMLOE or DMLOE = 1)

If minor loop mapping is enabled and SMLOE and DMLOE are cleared, then refer to the TCD_NBYTES_MLOFFNO register description. If minor loop mapping is disabled, then refer to the TCD_NBYTES_MLNO register description.



* Notes:

DMA_TCDn_NBYTES_MLOFFYES field descriptions

Field	Description									
31 SMLOE	Source Minor Loop Offset Enable									
	Selects whether the minor loop offset is applied to the source address upon minor loop completion.									
	0 The minor loop offset is not applied to the SADDR									
	1 The minor loop offset is applied to the SADDR									
30 DMLOE	Destination Minor Loop Offset enable									
	Selects whether the minor loop offset is applied to the destination address upon minor loop completion.									

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

x = Undefined at reset.

DMA_TCDn_NBYTES_MLOFFYES field descriptions (continued)

Field	Description
	0 The minor loop offset is not applied to the DADDR
	1 The minor loop offset is applied to the DADDR
29-10 MLOFF	If SMLOE or DMLOE is set, this field represents a sign-extended offset applied to the source or destination address to form the next-state value after the minor loop completes.
NBYTES	Minor Byte Transfer Count
	Number of bytes to be transferred in each service request of the channel.
	As a channel activates, the appropriate TCD contents load into the eDMA engine, and the appropriate reads and writes perform until the minor byte transfer count has transferred. This is an indivisible operation and cannot be halted. It can, however, be stalled by using the bandwidth control field, or via preemption. After the minor count is exhausted, the SADDR and DADDR values are written back into the TCD memory, the major iteration count is decremented and restored to the TCD memory. If the major iteration count is completed, additional processing is performed.

13.3.28 TCD Last Source Address Adjustment (DMA_TCDn_SLAST)

Address: 4000_8000h base + 100Ch offset + $(32d \times i)$, where i=0d to 7d



^{*} Notes:

DMA_TCDn_SLAST field descriptions

Field	Description
SLAST	Last Source Address Adjustment
	Adjustment value added to the source address at the completion of the major iteration count. This value can be applied to restore the source address to the initial value, or adjust the address to reference the next data structure.
	This register uses two's complement notation; the overflow bit is discarded.

13.3.29 TCD Destination Address (DMA_TCDn_DADDR)

Address: 4000_8000h base + 1010h offset + $(32d \times i)$, where i=0d to 7d



^{*} Notes:

232

x = Undefined at reset.

[•] x = Undefined at reset.

DMA_TCDn_DADDR field descriptions

Field	Description
DADDR	Destination Address
	Memory address pointing to the destination data.

13.3.30 TCD Signed Destination Address Offset (DMA_TCDn_DOFF)

Address: 4000_8000h base + 1014h offset + $(32d \times i)$, where i=0d to 7d

Bit	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
Read Write	DOFF															
Reset	X*	Х*	Х*	Х*	Х*	Х*	X*	Х*	Х*	Х*	Х*	X*	Х*	Х*	X*	X*

^{*} Notes:

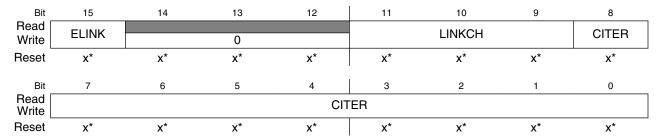
DMA_TCDn_DOFF field descriptions

Field	Description
DOFF	Destination Address Signed Offset Sign-extended offset applied to the current destination address to form the next-state value as each destination write is completed.

13.3.31 TCD Current Minor Loop Link, Major Loop Count (Channel Linking Enabled) (DMA_TCDn_CITER_ELINKYES)

If TCDn_CITER[ELINK] is set, the TCDn_CITER register is defined as follows.

Address: 4000_8000h base + 1016h offset + $(32d \times i)$, where i=0d to 7d



^{*} Notes:

NXP Semiconductors

233

[•] x = Undefined at reset.

x = Undefined at reset.

Memory map/register definition

DMA_TCDn_CITER_ELINKYES field descriptions

Field	Description
15	Enable channel-to-channel linking on minor-loop complete
ELINK	As the channel completes the minor loop, this flag enables linking to another channel, defined by the LINKCH field. The link target channel initiates a channel service request via an internal mechanism that sets the TCDn_CSR[START] bit of the specified channel.
	If channel linking is disabled, the CITER value is extended to 15 bits in place of a link channel number. If the major loop is exhausted, this link mechanism is suppressed in favor of the MAJORELINK channel linking.
	NOTE: This bit must be equal to the BITER[ELINK] bit; otherwise, a configuration error is reported.
	0 The channel-to-channel linking is disabled
	1 The channel-to-channel linking is enabled
14–12 Reserved	This field is reserved.
11–9 LINKCH	Minor Loop Link Channel Number
LINKCH	If channel-to-channel linking is enabled (ELINK = 1), then after the minor loop is exhausted, the eDMA engine initiates a channel service request to the channel defined by this field by setting that channel's TCDn_CSR[START] bit.
CITER	Current Major Iteration Count
	This 9-bit (ELINK = 1) or 15-bit (ELINK = 0) count represents the current major loop count for the channel. It is decremented each time the minor loop is completed and updated in the transfer control descriptor memory. After the major iteration count is exhausted, the channel performs a number of operations, for example, final source and destination address calculations, optionally generating an interrupt to signal channel completion before reloading the CITER field from the Beginning Iteration Count (BITER) field.
	NOTE: When the CITER field is initially loaded by software, it must be set to the same value as that contained in the BITER field.
	NOTE: If the channel is configured to execute a single service request, the initial values of BITER and CITER should be 0x0001.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

13.3.32 TCD Current Minor Loop Link, Major Loop Count (Channel Linking Disabled) (DMA_TCDn_CITER_ELINKNO)

If TCDn_CITER[ELINK] is cleared, the TCDn_CITER register is defined as follows.

Address: 4000_8000h base + 1016h offset + $(32d \times i)$, where i=0d to 7d

Bit	15	14	13	12	11	10	9	8
Read Write	ELINK				CITER			
Reset	x *							
Bit	7	6	5	4	3	2	1	0
Read Write				CIT	ER			
Reset	X *	x *	x *	x *	x*	x *	x *	X *

^{*} Notes:

DMA_TCDn_CITER_ELINKNO field descriptions

Field	Description					
15 ELINK	Enable channel-to-channel linking on minor-loop complete					
LLINK	As the channel completes the minor loop, this flag enables linking to another channel, defined by the LINKCH field. The link target channel initiates a channel service request via an internal mechanism that sets the TCDn_CSR[START] bit of the specified channel.					
	If channel linking is disabled, the CITER value is extended to 15 bits in place of a link channel number. If the major loop is exhausted, this link mechanism is suppressed in favor of the MAJORELINK channel linking.					
	NOTE: This bit must be equal to the BITER[ELINK] bit; otherwise, a configuration error is reported.					
	0 The channel-to-channel linking is disabled					
	1 The channel-to-channel linking is enabled					
CITER	Current Major Iteration Count					
	This 9-bit (ELINK = 1) or 15-bit (ELINK = 0) count represents the current major loop count for the channel it is decremented each time the minor loop is completed and updated in the transfer control descriptor memory. After the major iteration count is exhausted, the channel performs a number of operations, for example, final source and destination address calculations, optionally generating an interrupt to signal channel completion before reloading the CITER field from the Beginning Iteration Count (BITER) field.					
	NOTE: When the CITER field is initially loaded by software, it must be set to the same value as that contained in the BITER field.					
	NOTE: If the channel is configured to execute a single service request, the initial values of BITER and CITER should be 0x0001.					

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

[•] x = Undefined at reset.

13.3.33 TCD Last Destination Address Adjustment/Scatter Gather Address (DMA_TCDn_DLASTSGA)

Address: 4000_8000h base + 1018h offset + $(32d \times i)$, where i=0d to 7d



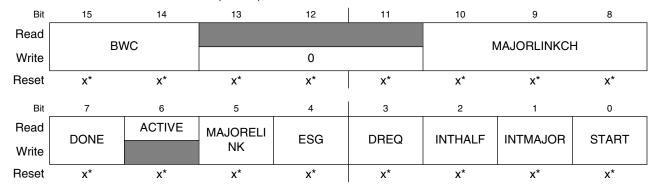
^{*} Notes:

DMA_TCDn_DLASTSGA field descriptions

Field	Description
DLASTSGA	Destination last address adjustment or the memory address for the next transfer control descriptor to be loaded into this channel (scatter/gather).
	If (TCDn_CSR[ESG] = 0) then:
	 Adjustment value added to the destination address at the completion of the major iteration count. This value can apply to restore the destination address to the initial value or adjust the address to reference the next data structure. This field uses two's complement notation for the final destination address adjustment.
	Otherwise:
	 This address points to the beginning of a 0-modulo-32-byte region containing the next transfer control descriptor to be loaded into this channel. This channel reload is performed as the major iteration count completes. The scatter/gather address must be 0-modulo-32-byte, otherwise a configuration error is reported.

13.3.34 TCD Control and Status (DMA_TCDn_CSR)

Address: 4000_8000h base + 101Ch offset + $(32d \times i)$, where i=0d to 7d



^{*} Notes:

x = Undefined at reset.

x = Undefined at reset.

DMA_TCDn_CSR field descriptions

Field	Description					
15–14	Bandwidth Control					
BWC	Throttles the amount of bus bandwidth consumed by the eDMA. Generally, as the eDMA processes the minor loop, it continuously generates read/write sequences until the minor count is exhausted. This field forces the eDMA to stall after the completion of each read/write access to control the bus request bandwidth seen by the crossbar switch.					
	00 No eDMA engine stalls.					
	01 Reserved					
	10 eDMA engine stalls for 4 cycles after each R/W.					
	11 eDMA engine stalls for 8 cycles after each R/W.					
13–11 Reserved	This field is reserved.					
10–8 MAJORLINKCH	Major Loop Link Channel Number					
IVIAJORLIINKOR	If (MAJORELINK = 0) then: • No channel-to-channel linking, or chaining, is performed after the major loop counter is exhausted.					
	Otherwise:					
	After the major loop counter is exhausted, the eDMA engine initiates a channel service request at the channel defined by this field by setting that channel's TCDn_CSR[START] bit.					
7	Channel Done					
DONE	This flag indicates the eDMA has completed the major loop. The eDMA engine sets it as the CITER count reaches zero. The software clears it, or the hardware when the channel is activated.					
	The access of this field is W0C, write-zero-to-clear.					
	NOTE: This bit must be cleared to write the MAJORELINK or ESG bits.					
6 ACTIVE	Channel Active					
ACTIVE	This flag signals the channel is currently in execution. It is set when channel service begins, and is cleared by the eDMA as the minor loop completes or when any error condition is detected.					
5	Enable channel-to-channel linking on major loop complete					
MAJORELINK	As the channel completes the major loop, this flag enables the linking to another channel, defined by MAJORLINKCH. The link target channel initiates a channel service request via an internal mechanism that sets the TCDn_CSR[START] bit of the specified channel.					
	NOTE: To support the dynamic linking coherency model, this field is forced to zero when written to while the TCDn_CSR[DONE] bit is set.					
	0 The channel-to-channel linking is disabled.					
	1 The channel-to-channel linking is enabled.					
4	Enable Scatter/Gather Processing					
ESG	As the channel completes the major loop, this flag enables scatter/gather processing in the current channel. If enabled, the eDMA engine uses DLASTSGA as a memory pointer to a 0-modulo-32 address containing a 32-byte data structure loaded as the transfer control descriptor into the local memory.					
	NOTE: To support the dynamic scatter/gather coherency model, this field is forced to zero when written to while the TCDn_CSR[DONE] bit is set.					

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3,07/2018

Memory map/register definition

DMA_TCDn_CSR field descriptions (continued)

Field	Description						
	0 The current channel's TCD is normal format.						
	1 The current channel's TCD specifies a scatter gather format. The DLASTSGA field provides a memory pointer to the next TCD to be loaded into this channel after the major loop completes its execution.						
3	Disable Request						
DREQ	If this flag is set, the eDMA hardware automatically clears the corresponding ERQ bit when the current major iteration count reaches zero.						
	0 The channel's ERQ bit is not affected.						
	1 The channel's ERQ bit is cleared when the major loop is complete.						
2	Enable an interrupt when major counter is half complete.						
INTHALF	If this flag is set, the channel generates an interrupt request by setting the appropriate bit in the INT register when the current major iteration count reaches the halfway point. Specifically, the comparison performed by the eDMA engine is (CITER == (BITER >> 1)). This halfway point interrupt request is provided to support double-buffered, also known as ping-pong, schemes or other types of data movement where the processor needs an early indication of the transfer's progress.						
	NOTE: If BITER = 1, do not use INTHALF. Use INTMAJOR instead.						
	0 The half-point interrupt is disabled.						
	1 The half-point interrupt is enabled.						
1	Enable an interrupt when major iteration count completes.						
INTMAJOR	If this flag is set, the channel generates an interrupt request by setting the appropriate bit in the INT when the current major iteration count reaches zero.						
	0 The end-of-major loop interrupt is disabled.						
	1 The end-of-major loop interrupt is enabled.						
0 START	Channel Start						
	If this flag is set, the channel is requesting service. The eDMA hardware automatically clears this flag after the channel begins execution.						
	0 The channel is not explicitly started.						
	1 The channel is explicitly started via a software initiated service request.						

13.3.35 TCD Beginning Minor Loop Link, Major Loop Count (Channel Linking Enabled) (DMA_TCDn_BITER_ELINKYES)

If the TCDn_BITER[ELINK] bit is set, the TCDn_BITER register is defined as follows.

Address: 4000_8000h base + 101Eh offset + $(32d \times i)$, where i=0d to 7d

Bit	15	14	13	12	11	10	9	8
Read Write	ELINK		0			LINKCH		BITER
Reset	x *	X*	x *	X*				
Bit	7	6	5	4	3	2	1	0
Read Write				BIT	ER			
Reset	x *	X*						

^{*} Notes:

DMA_TCDn_BITER_ELINKYES field descriptions

Field	Description
15 ELINK	Enables channel-to-channel linking on minor loop complete
LLINK	As the channel completes the minor loop, this flag enables the linking to another channel, defined by BITER[LINKCH]. The link target channel initiates a channel service request via an internal mechanism that sets the TCDn_CSR[START] bit of the specified channel. If channel linking disables, the BITER value extends to 15 bits in place of a link channel number. If the major loop is exhausted, this link mechanism is suppressed in favor of the MAJORELINK channel linking.
	NOTE: When the software loads the TCD, this field must be set equal to the corresponding CITER field; otherwise, a configuration error is reported. As the major iteration count is exhausted, the contents of this field are reloaded into the CITER field.
	0 The channel-to-channel linking is disabled
	1 The channel-to-channel linking is enabled
14–12 Reserved	This field is reserved.
11–9	Link Channel Number
LINKCH	If channel-to-channel linking is enabled (ELINK = 1), then after the minor loop is exhausted, the eDMA engine initiates a channel service request at the channel defined by this field by setting that channel's TCDn_CSR[START] bit.
	NOTE: When the software loads the TCD, this field must be set equal to the corresponding CITER field; otherwise, a configuration error is reported. As the major iteration count is exhausted, the contents of this field are reloaded into the CITER field.
BITER	Starting major iteration count
	As the transfer control descriptor is first loaded by software, this 9-bit (ELINK = 1) or 15-bit (ELINK = 0) field must be equal to the value in the CITER field. As the major iteration count is exhausted, the contents of this field are reloaded into the CITER field.

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

x = Undefined at reset.

Memory map/register definition

DMA_TCDn_BITER_ELINKYES field descriptions (continued)

	Field		Description
I		NOTE:	When the software loads the TCD, this field must be set equal to the corresponding CITER field;
l			otherwise, a configuration error is reported. As the major iteration count is exhausted, the
			contents of this field are reloaded into the CITER field. If the channel is configured to execute a
			single service request, the initial values of BITER and CITER should be 0x0001.

13.3.36 TCD Beginning Minor Loop Link, Major Loop Count (Channel Linking Disabled) (DMA_TCDn_BITER_ELINKNO)

If the TCDn_BITER[ELINK] bit is cleared, the TCDn_BITER register is defined as follows.

Address: 4000_8000h base + 101Eh offset + $(32d \times i)$, where i=0d to 7d

Bit	15	14	13	12	11	10	9	8
Read Write	ELINK				BITER			
Reset	X *							
Bit	7	6	5	4	3	2	1	0
Read Write				BIT	ER			
Reset	x *							

^{*} Notes:

DMA_TCDn_BITER_ELINKNO field descriptions

Field	Description					
15 ELINK	Enables channel-to-channel linking on minor loop complete					
ELINK	As the channel completes the minor loop, this flag enables the linking to another channel, defined by BITER[LINKCH]. The link target channel initiates a channel service request via an internal mechanism that sets the TCDn_CSR[START] bit of the specified channel. If channel linking is disabled, the BITER value extends to 15 bits in place of a link channel number. If the major loop is exhausted, this link mechanism is suppressed in favor of the MAJORELINK channel linking.					
	NOTE: When the software loads the TCD, this field must be set equal to the corresponding CITER field; otherwise, a configuration error is reported. As the major iteration count is exhausted, the contents of this field are reloaded into the CITER field.					
	0 The channel-to-channel linking is disabled					
	1 The channel-to-channel linking is enabled					
BITER	Starting Major Iteration Count					
	As the transfer control descriptor is first loaded by software, this 9-bit (ELINK = 1) or 15-bit (ELINK = 0) field must be equal to the value in the CITER field. As the major iteration count is exhausted, the contents of this field are reloaded into the CITER field.					
	NOTE: When the software loads the TCD, this field must be set equal to the corresponding CITER field; otherwise, a configuration error is reported. As the major iteration count is exhausted, the					

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

[•] x = Undefined at reset.

DMA_TCDn_BITER_ELINKNO field descriptions (continued)

Field	Description
	contents of this field is reloaded into the CITER field. If the channel is configured to execute a single service request, the initial values of BITER and CITER should be 0x0001.

13.4 Functional description

The operation of the eDMA is described in the following subsections.

13.4.1 eDMA basic data flow

The basic flow of a data transfer can be partitioned into three segments.

As shown in the following diagram, the first segment involves the channel activation:

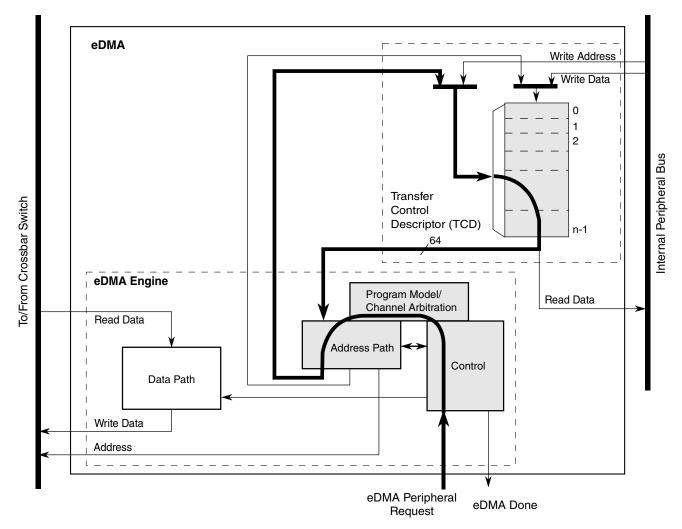


Figure 13-2. eDMA operation, part 1

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Functional description

This example uses the assertion of the eDMA peripheral request signal to request service for channel n. Channel activation via software and the TCDn_CSR[START] bit follows the same basic flow as peripheral requests. The eDMA request input signal is registered internally and then routed through the eDMA engine: first through the control module, then into the program model and channel arbitration. In the next cycle, the channel arbitration performs, using the fixed-priority or round-robin algorithm. After arbitration is complete, the activated channel number is sent through the address path and converted into the required address to access the local memory for TCDn. Next, the TCD memory is accessed and the required descriptor read from the local memory and loaded into the eDMA engine address path channel x or y registers. The TCD memory is 64 bits wide to minimize the time needed to fetch the activated channel descriptor and load it into the address path channel x or y registers.

The following diagram illustrates the second part of the basic data flow:

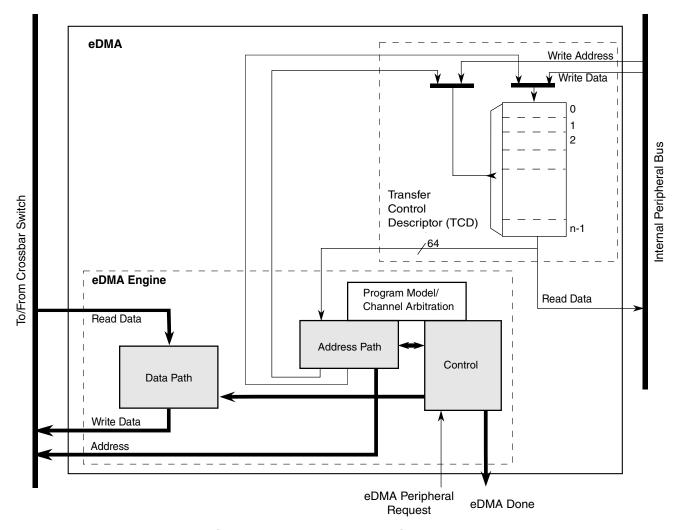


Figure 13-3, eDMA operation, part 2

The modules associated with the data transfer (address path, data path, and control) sequence through the required source reads and destination writes to perform the actual data movement. The source reads are initiated and the fetched data is temporarily stored in the data path block until it is gated onto the internal bus during the destination write. This source read/destination write processing continues until the minor byte count has transferred.

After the minor byte count has moved, the final phase of the basic data flow is performed. In this segment, the address path logic performs the required updates to certain fields in the appropriate TCD, for example, SADDR, DADDR, CITER. If the major iteration count is exhausted, additional operations are performed. These include the final address adjustments and reloading of the BITER field into the CITER. Assertion of an optional interrupt request also occurs at this time, as does a possible fetch of a new TCD from memory using the scatter/gather address pointer included in the descriptor (if scatter/gather is enabled). The updates to the TCD memory and the assertion of an interrupt request are shown in the following diagram.

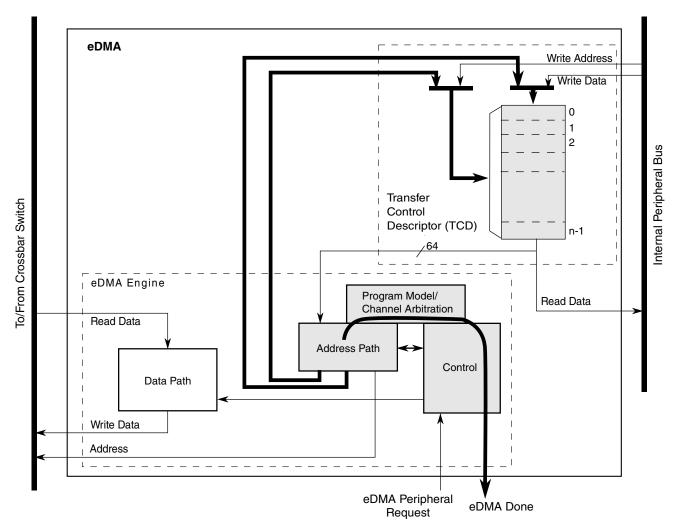


Figure 13-4. eDMA operation, part 3

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

13.4.2 Fault reporting and handling

Channel errors are reported in the Error Status register (DMAx_ES) and can be caused by:

- A configuration error, which is an illegal setting in the transfer-control descriptor or an illegal priority register setting in Fixed-Arbitration mode, or
- An error termination to a bus master read or write cycle

A configuration error is reported when the starting source or destination address, source or destination offsets, minor loop byte count, or the transfer size represent an inconsistent state. Each of these possible causes are detailed below:

- The addresses and offsets must be aligned on 0-modulo-transfer-size boundaries.
- The minor loop byte count must be a multiple of the source and destination transfer sizes.
- All source reads and destination writes must be configured to the natural boundary of the programmed transfer size respectively.
- In fixed arbitration mode, a configuration error is caused by any two channel priorities being equal. All channel priority levels must be unique when fixed arbitration mode is enabled.

NOTE

When two channels have the same priority, a channel priority error exists and will be reported in the Error Status register. However, the channel number will not be reported in the Error Status register. When all of the channel priorities within a group are not unique, the channel number selected by arbitration is undetermined.

To aid in Channel Priority Error (CPE) debug, set the Halt On Error bit in the DMA's Control Register. If all of the channel priorities within a group are not unique, the DMA will be halted after the CPE error is recorded. The DMA will remain halted and will not process any channel service requests. Once all of the channel priorities are set to unique numbers, the DMA may be enabled again by clearing the Halt bit.

- If a scatter/gather operation is enabled upon channel completion, a configuration error is reported if the scatter/gather address (DLAST_SGA) is not aligned on a 32-byte boundary.
- If minor loop channel linking is enabled upon channel completion, a configuration error is reported when the link is attempted if the TCDn_CITER[E_LINK] bit does not equal the TCDn_BITER[E_LINK] bit.

If enabled, all configuration error conditions, except the scatter/gather and minor-loop link errors, report as the channel activates and asserts an error interrupt request. A scatter/gather configuration error is reported when the scatter/gather operation begins at major loop completion when properly enabled. A minor loop channel link configuration error is reported when the link operation is serviced at minor loop completion.

If a system bus read or write is terminated with an error, the data transfer is stopped and the appropriate bus error flag set. In this case, the state of the channel's transfer control descriptor is updated by the eDMA engine with the current source address, destination address, and current iteration count at the point of the fault. When a system bus error occurs, the channel terminates after the next transfer. Due to pipeline effect, the next transfer is already in progress when the bus error is received by the eDMA. If a bus error occurs on the last read prior to beginning the write sequence, the write executes using the data captured during the bus error. If a bus error occurs on the last write prior to switching to the next read sequence, the read sequence executes before the channel terminates due to the destination bus error.

A transfer may be cancelled by software with the CR[CX] bit. When a cancel transfer request is recognized, the DMA engine stops processing the channel. The current readwrite sequence is allowed to finish. If the cancel occurs on the last read-write sequence of a major or minor loop, the cancel request is discarded and the channel retires normally.

The error cancel transfer is the same as a cancel transfer except the Error Status register (DMAx_ES) is updated with the cancelled channel number and ECX is set. The TCD of a cancelled channel contains the source and destination addresses of the last transfer saved in the TCD. If the channel needs to be restarted, you must re-initialize the TCD because the aforementioned fields no longer represent the original parameters. When a transfer is cancelled by the error cancel transfer mechanism, the channel number is loaded into DMA_ES[ERRCHN] and ECX and VLD are set. In addition, an error interrupt may be generated if enabled.

NOTE

The cancel transfer request allows the user to stop a large data transfer in the event the full data transfer is no longer needed. The cancel transfer bit does not abort the channel. It simply stops the transferring of data and then retires the channel through its normal shutdown sequence. The application

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Functional description

software must handle the context of the cancel. If an interrupt is desired (or not), then the interrupt should be enabled (or disabled) before the cancel request. The application software must clean up the transfer control descriptor since the full transfer did not occur.

The occurrence of any error causes the eDMA engine to stop normal processing of the active channel immediately (it goes to its error processing states and the transaction to the system bus still has pipeline effect), and the appropriate channel bit in the eDMA error register is asserted. At the same time, the details of the error condition are loaded into the Error Status register (DMAx_ES). The major loop complete indicators, setting the transfer control descriptor DONE flag and the possible assertion of an interrupt request, are not affected when an error is detected. After the error status has been updated, the eDMA engine continues operating by servicing the next appropriate channel. A channel that experiences an error condition is not automatically disabled. If a channel is terminated by an error and then issues another service request before the error is fixed, that channel executes and terminates with the same error condition.

13.4.3 Channel preemption

Channel preemption is enabled on a per-channel basis by setting the DCHPRIn[ECP] bit. Channel preemption allows the executing channel's data transfers to temporarily suspend in favor of starting a higher priority channel. After the preempting channel has completed all its minor loop data transfers, the preempted channel is restored and resumes execution. After the restored channel completes one read/write sequence, it is again eligible for preemption. If any higher priority channel is requesting service, the restored channel is suspended and the higher priority channel is serviced. Nested preemption, that is, attempting to preempt a preempting channel, is not supported. After a preempting channel begins execution, it cannot be preempted. Preemption is available only when fixed arbitration is selected.

A channel's ability to preempt another channel can be disabled by setting DCHPRIn[DPA]. When a channel's preempt ability is disabled, that channel cannot suspend a lower priority channel's data transfer, regardless of the lower priority channel's ECP setting. This allows for a pool of low priority, large data-moving channels to be defined. These low priority channels can be configured to not preempt each other, thus preventing a low priority channel from consuming the preempt slot normally available to a true, high priority channel.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

13.4.4 Performance

This section addresses the performance of the eDMA module, focusing on two separate metrics:

- In the traditional data movement context, performance is best expressed as the peak data transfer rates achieved using the eDMA. In most implementations, this transfer rate is limited by the speed of the source and destination address spaces.
- In a second context where device-paced movement of single data values to/from peripherals is dominant, a measure of the requests that can be serviced in a fixed time is a more relevant metric. In this environment, the speed of the source and destination address spaces remains important. However, the microarchitecture of the eDMA also factors significantly into the resulting metric.

13.4.4.1 Peak transfer rates

The peak transfer rates for several different source and destination transfers are shown in the following tables. These tables assume:

- Internal SRAM can be accessed with zero wait-states when viewed from the system bus data phase
- All internal peripheral bus reads require two wait-states, and internal peripheral bus writes three wait-states, when viewed from the system bus data phase
- All internal peripheral bus accesses are 32-bits in size

NOTE

All architectures will not meet the assumptions listed above. See the SRAM configuration section for more information.

This table compares peak transfer rates based on different possible system speeds. Specific chips/devices may not support all system speeds listed.

Table 13-4. eDMA peak transfer rates (Mbytes/sec)

Custom Coasal Width	Internal SRAM-to-	32 bit internal peripheral	Internal SRAM-to-32 bit
System Speed, Width	Internal SRAM	bus-to-Internal SRAM	internal peripheral bus
48 MHz, 32 bit	96.0	48.0	38.4
66.7 MHz, 32 bit	133.3	66.7	53.3
83.3 MHz, 32 bit	166.7	83.3	66.7
100.0 MHz, 32 bit	200.0	100.0	80.0
133.3 MHz, 32 bit	266.7	133.3	106.7
150.0 MHz, 32 bit	300.0	150.0	120.0

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Functional description

Internal-SRAM-to-internal-SRAM transfers occur at the core's datapath width. For all transfers involving the internal peripheral bus, 32-bit transfer sizes are used. In all cases, the transfer rate includes the time to read the source plus the time to write the destination.

13.4.4.2 Peak request rates

The second performance metric is a measure of the number of DMA requests that can be serviced in a given amount of time. For this metric, assume that the peripheral request causes the channel to move a single internal peripheral bus-mapped operand to/from internal SRAM. The same timing assumptions used in the previous example apply to this calculation. In particular, this metric also reflects the time required to activate the channel.

The eDMA design supports the following hardware service request sequence. Note that the exact timing from Cycle 7 is a function of the response times for the channel's read and write accesses. In the case of an internal peripheral bus read and internal SRAM write, the combined data phase time is 4 cycles. For an SRAM read and internal peripheral bus write, it is 5 cycles.

Table 13-5. Hardware service request process

Cycle		Description
With internal peripheral bus read and internal SRAM write	With SRAM read and internal peripheral bus write	
-	1	eDMA peripheral request is asserted.
2		The eDMA peripheral request is registered locally in the eDMA module and qualified. TCDn_CSR[START] bit initiated requests start at this point with the registering of the user write to TCDn word 7.
	3	Channel arbitration begins.
4		Channel arbitration completes. The transfer control descriptor local memory read is initiated.
5–6		The first two parts of the activated channel's TCD is read from the local memory. The memory width to the eDMA engine is 64 bits, so the entire descriptor can be accessed in four cycles
7		The first system bus read cycle is initiated, as the third part of the channel's TCD is read from the local memory. Depending on the state of the crossbar switch, arbitration at the system bus may insert an additional cycle of delay here.
8–11	8–12	The last part of the TCD is read in. This cycle represents the first data phase for the read, and the address phase for the destination write.

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Table 13-5. Hardware service request process (continued)

Cycle		Description
With internal peripheral bus read and internal SRAM write	With SRAM read and internal peripheral bus write	
12	13	This cycle represents the data phase of the last destination write.
13	14	The eDMA engine completes the execution of the inner minor loop and prepares to write back the required TCD <i>n</i> fields into the local memory. The TCD <i>n</i> word 7 is read and checked for channel linking or scatter/gather requests.
14	15	The appropriate fields in the first part of the TCD <i>n</i> are written back into the local memory.
15	16	The fields in the second part of the TCD <i>n</i> are written back into the local memory. This cycle coincides with the next channel arbitration cycle start.
16	17	The next channel to be activated performs the read of the first part of its TCD from the local memory. This is equivalent to Cycle 4 for the first channel's service request.

Assuming zero wait states on the system bus, DMA requests can be processed every 9 cycles. Assuming an average of the access times associated with internal peripheral bus-to-SRAM (4 cycles) and SRAM-to-internal peripheral bus (5 cycles), DMA requests can be processed every 11.5 cycles (4 + (4+5)/2 + 3). This is the time from Cycle 4 to Cycle x +5. The resulting peak request rate, as a function of the system frequency, is shown in the following table.

Table 13-6. eDMA peak request rate (MReq/sec)

Occabent for many (AUI)	Request rate	Request rate
System frequency (MHz)	with zero wait states	with wait states
48.0	5.3	4.2
66.6	7.4	5.8
83.3	9.2	7.2
100.0	11.1	8.7
133.3	14.8	11.6
150.0	16.6	13.0

A general formula to compute the peak request rate with overlapping requests is:

where:

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Table 13-7. Peak request formula operands

Operand	Description
PEAKreq	Peak request rate
freq	System frequency
entry	Channel startup (4 cycles)
read_ws	Wait states seen during the system bus read data phase
write_ws	Wait states seen during the system bus write data phase
exit	Channel shutdown (3 cycles)

13.4.4.3 eDMA performance example

Consider a system with the following characteristics:

- Internal SRAM can be accessed with one wait-state when viewed from the system bus data phase
- All internal peripheral bus reads require two wait-states, and internal peripheral bus writes three wait-states viewed from the system bus data phase
- System operates at 150 MHz

For an SRAM to internal peripheral bus transfer,

$$PEAKreq = 150 MHz / [4 + (1 + 1) + (1 + 3) + 3] cycles = 11.5 Mreq/sec$$

For an internal peripheral bus to SRAM transfer,

$$PEAKreq = 150 MHz / [4 + (1 + 2) + (1 + 1) + 3] cycles = 12.5 Mreg/sec$$

Assuming an even distribution of the two transfer types, the average peak request rate would be:

$$PEAKreq = (11.5 Mreq/sec + 12.5 Mreq/sec) / 2 = 12.0 Mreq/sec$$

The minimum number of cycles to perform a single read/write, zero wait states on the system bus, from a cold start where no channel is executing and eDMA is idle are:

- 11 cycles for a software, that is, a TCDn_CSR[START] bit, request
- 12 cycles for a hardware, that is, an eDMA peripheral request signal, request

Two cycles account for the arbitration pipeline and one extra cycle on the hardware request resulting from the internal registering of the eDMA peripheral request signals. For the peak request rate calculations above, the arbitration and request registering is absorbed in or overlaps the previous executing channel.

Note

When channel linking or scatter/gather is enabled, a two cycle delay is imposed on the next channel selection and startup. This allows the link channel or the scatter/gather channel to be eligible and considered in the arbitration pool for next channel selection.

13.5 Initialization/application information

The following sections discuss initialization of the eDMA and programming considerations.

13.5.1 eDMA initialization

To initialize the eDMA:

- 1. Write to the CR if a configuration other than the default is desired.
- 2. Write the channel priority levels to the DCHPRI*n* registers if a configuration other than the default is desired.
- 3. Enable error interrupts in the EEI register if so desired.
- 4. Write the 32-byte TCD for each channel that may request service.
- 5. Enable any hardware service requests via the ERQ register.
- 6. Request channel service via either:
 - Software: setting the TCD*n*_CSR[START]
 - Hardware: slave device asserting its eDMA peripheral request signal

After any channel requests service, a channel is selected for execution based on the arbitration and priority levels written into the programmer's model. The eDMA engine reads the entire TCD, including the TCD control and status fields, as shown in the following table, for the selected channel into its internal address path module.

NXP Semiconductors

251

Initialization/application information

As the TCD is read, the first transfer is initiated on the internal bus, unless a configuration error is detected. Transfers from the source, as defined by TCD*n*_SADDR, to the destination, as defined by TCD*n*_DADDR, continue until the number of bytes specified by TCD*n*_NBYTES are transferred.

When the transfer is complete, the eDMA engine's local TCD*n*_SADDR, TCD*n*_DADDR, and TCD*n*_CITER are written back to the main TCD memory and any minor loop channel linking is performed, if enabled. If the major loop is exhausted, further post processing executes, such as interrupts, major loop channel linking, and scatter/gather operations, if enabled.

TCDn_CSR field name	Description
START	Control bit to start channel explicitly when using a software initiated DMA service (Automatically cleared by hardware)
ACTIVE	Status bit indicating the channel is currently in execution
DONE	Status bit indicating major loop completion (cleared by software when using a software initiated DMA service)
D_REQ	Control bit to disable DMA request at end of major loop completion when using a hardware initiated DMA service
BWC	Control bits for throttling bandwidth control of a channel
E_SG	Control bit to enable scatter-gather feature
INT_HALF	Control bit to enable interrupt when major loop is half complete
INT_MAJ	Control bit to enable interrupt when major loop completes

Table 13-8. TCD Control and Status fields

The following figure shows how each DMA request initiates one minor-loop transfer, or iteration, without CPU intervention. DMA arbitration can occur after each minor loop, and one level of minor loop DMA preemption is allowed. The number of minor loops in a major loop is specified by the beginning iteration count (BITER).

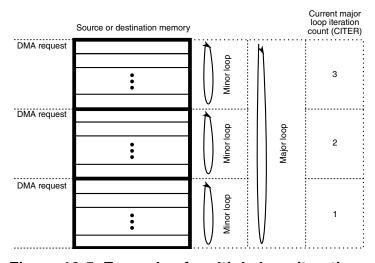


Figure 13-5. Example of multiple loop iterations

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

The following figure lists the memory array terms and how the TCD settings interrelate.

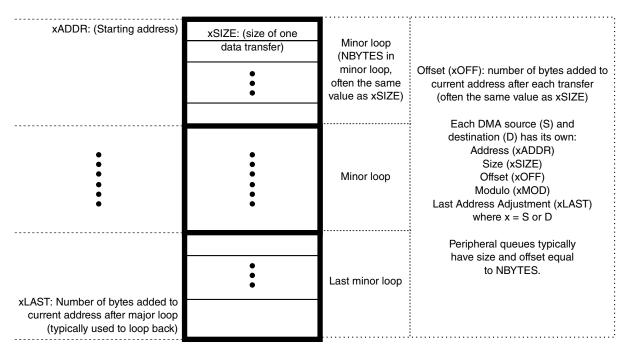


Figure 13-6. Memory array terms

13.5.2 Programming errors

The eDMA performs various tests on the transfer control descriptor to verify consistency in the descriptor data. Most programming errors are reported on a per channel basis with the exception of channel priority error (ES[CPE]).

For all error types other than channel priority error, the channel number causing the error is recorded in the Error Status register (DMAx_ES). If the error source is not removed before the next activation of the problem channel, the error is detected and recorded again.

If priority levels are not unique, when any channel requests service, a channel priority error is reported. The highest channel priority with an active request is selected, but the lowest numbered channel with that priority is selected by arbitration and executed by the eDMA engine. The hardware service request handshake signals, error interrupts, and error reporting is associated with the selected channel.

13.5.3 Arbitration mode considerations

This section discusses arbitration considerations for the eDMA.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

13.5.3.1 Fixed channel arbitration

In this mode, the channel service request from the highest priority channel is selected to execute.

13.5.3.2 Round-robin channel arbitration

Channels are serviced starting with the highest channel number and rotating through to the lowest channel number without regard to the channel priority levels.

13.5.4 Performing DMA transfers

This section presents examples on how to perform DMA transfers with the eDMA.

13.5.4.1 Single request

To perform a simple transfer of n bytes of data with one activation, set the major loop to one (TCDn_CITER = TCDn_BITER = 1). The data transfer begins after the channel service request is acknowledged and the channel is selected to execute. After the transfer is complete, the TCDn_CSR[DONE] bit is set and an interrupt generates if properly enabled.

For example, the following TCD entry is configured to transfer 16 bytes of data. The eDMA is programmed for one iteration of the major loop transferring 16 bytes per iteration. The source memory has a byte wide memory port located at 0x1000. The destination memory has a 32-bit port located at 0x2000. The address offsets are programmed in increments to match the transfer size: one byte for the source and four bytes for the destination. The final source and destination addresses are adjusted to return to their beginning values.

```
TCDn_CITER = TCDn_BITER = 1
TCDn_NBYTES = 16
TCDn_SADDR = 0x1000
TCDn_SOFF = 1
TCDn_ATTR[SSIZE] = 0
TCDn_SLAST = -16
TCDn_DADDR = 0x2000
TCDn_DADDR = 0x2000
TCDn_DAFF = 4
TCDn_ATTR[DSIZE] = 2
TCDn_DLAST_SGA= -16
TCDn_CSR[INT_MAJ] = 1
TCDn_CSR[START] = 1 (Should be written last after all other fields have been initialized)
All other TCDn fields = 0
```

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

This generates the following event sequence:

- 1. User write to the TCDn_CSR[START] bit requests channel service.
- 2. The channel is selected by arbitration for servicing.
- 3. eDMA engine writes: $TCDn_CSR[DONE] = 0$, $TCDn_CSR[START] = 0$, $TCDn_CSR[ACTIVE] = 1$.
- 4. eDMA engine reads: channel TCD data from local memory to internal register file.
- 5. The source-to-destination transfers are executed as follows:
 - a. Read byte from location 0x1000, read byte from location 0x1001, read byte from 0x1002, read byte from 0x1003.
 - b. Write 32-bits to location $0x2000 \rightarrow$ first iteration of the minor loop.
 - c. Read byte from location 0x1004, read byte from location 0x1005, read byte from 0x1006, read byte from 0x1007.
 - d. Write 32-bits to location $0x2004 \rightarrow$ second iteration of the minor loop.
 - e. Read byte from location 0x1008, read byte from location 0x1009, read byte from 0x100A, read byte from 0x100B.
 - f. Write 32-bits to location $0x2008 \rightarrow$ third iteration of the minor loop.
 - g. Read byte from location 0x100C, read byte from location 0x100D, read byte from 0x100E, read byte from 0x100F.
 - h. Write 32-bits to location $0x200C \rightarrow last$ iteration of the minor loop \rightarrow major loop complete.
- 6. The eDMA engine writes: $TCDn_SADDR = 0x1000$, $TCDn_DADDR = 0x2000$, $TCDn_CITER = 1$ ($TCDn_BITER$).
- 7. The eDMA engine writes: $TCDn_CSR[ACTIVE] = 0$, $TCDn_CSR[DONE] = 1$, INT[n] = 1.
- 8. The channel retires and the eDMA goes idle or services the next channel.

NXP Semiconductors

255

13.5.4.2 Multiple requests

The following example transfers 32 bytes via two hardware requests, but is otherwise the same as the previous example. The only fields that change are the major loop iteration count and the final address offsets. The eDMA is programmed for two iterations of the major loop transferring 16 bytes per iteration. After the channel's hardware requests are enabled in the ERQ register, the slave device initiates channel service requests.

```
TCDn_CITER = TCDn_BITER = 2
TCDn_SLAST = -32
TCDn_DLAST_SGA = -32
```

This would generate the following sequence of events:

- 1. First hardware, that is, eDMA peripheral, request for channel service.
- 2. The channel is selected by arbitration for servicing.
- 3. eDMA engine writes: $TCDn_CSR[DONE] = 0$, $TCDn_CSR[START] = 0$, $TCDn_CSR[ACTIVE] = 1$.
- 4. eDMA engine reads: channel TCDn data from local memory to internal register file.
- 5. The source to destination transfers are executed as follows:
 - a. Read byte from location 0x1000, read byte from location 0x1001, read byte from 0x1002, read byte from 0x1003.
 - b. Write 32-bits to location $0x2000 \rightarrow$ first iteration of the minor loop.
 - c. Read byte from location 0x1004, read byte from location 0x1005, read byte from 0x1006, read byte from 0x1007.
 - d. Write 32-bits to location $0x2004 \rightarrow$ second iteration of the minor loop.
 - e. Read byte from location 0x1008, read byte from location 0x1009, read byte from 0x100A, read byte from 0x100B.
 - f. Write 32-bits to location $0x2008 \rightarrow$ third iteration of the minor loop.
 - g. Read byte from location 0x100C, read byte from location 0x100D, read byte from 0x100E, read byte from 0x100F.
 - h. Write 32-bits to location $0x200C \rightarrow last$ iteration of the minor loop.
- 6. eDMA engine writes: $TCDn_SADDR = 0x1010$, $TCDn_DADDR = 0x2010$, $TCDn_CITER = 1$.
- 7. eDMA engine writes: $TCDn_CSR[ACTIVE] = 0$.

- 8. The channel retires \rightarrow one iteration of the major loop. The eDMA goes idle or services the next channel.
- 9. Second hardware, that is, eDMA peripheral, requests channel service.
- 10. The channel is selected by arbitration for servicing.
- 11. eDMA engine writes: $TCDn_CSR[DONE] = 0$, $TCDn_CSR[START] = 0$, $TCDn_CSR[ACTIVE] = 1.$
- 12. eDMA engine reads: channel TCD data from local memory to internal register file.
- 13. The source to destination transfers are executed as follows:
 - a. Read byte from location 0x1010, read byte from location 0x1011, read byte from 0x1012, read byte from 0x1013.
 - b. Write 32-bits to location $0x2010 \rightarrow$ first iteration of the minor loop.
 - c. Read byte from location 0x1014, read byte from location 0x1015, read byte from 0x1016, read byte from 0x1017.
 - d. Write 32-bits to location $0x2014 \rightarrow$ second iteration of the minor loop.
 - e. Read byte from location 0x1018, read byte from location 0x1019, read byte from 0x101A, read byte from 0x101B.
 - f. Write 32-bits to location $0x2018 \rightarrow$ third iteration of the minor loop.
 - g. Read byte from location 0x101C, read byte from location 0x101D, read byte from 0x101E, read byte from 0x101F.
 - h. Write 32-bits to location $0x201C \rightarrow last$ iteration of the minor loop \rightarrow major loop complete.
- 14. eDMA engine writes: TCDn SADDR = 0x1000, TCDn DADDR = 0x2000, $TCDn_CITER = 2 (TCDn_BITER).$
- 15. eDMA engine writes: $TCDn_CSR[ACTIVE] = 0$, $TCDn_CSR[DONE] = 1$, INT[n] =
- 16. The channel retires \rightarrow major loop complete. The eDMA goes idle or services the next channel.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

257

13.5.4.3 Using the modulo feature

The modulo feature of the eDMA provides the ability to implement a circular data queue in which the size of the gueue is a power of 2. MOD is a 5-bit field for the source and destination in the TCD, and it specifies which lower address bits increment from their original value after the address+offset calculation. All upper address bits remain the same as in the original value. A setting of 0 for this field disables the modulo feature.

The following table shows how the transfer addresses are specified based on the setting of the MOD field. Here a circular buffer is created where the address wraps to the original value while the 28 upper address bits (0x1234567x) retain their original value. In this example the source address is set to 0x12345670, the offset is set to 4 bytes and the MOD field is set to 4, allowing for a 2⁴ byte (16-byte) size queue.

Transfer Number	Address
1	0x12345670
2	0x12345674
3	0x12345678
4	0x1234567C
5	0x12345670
6	0x12345674

Table 13-9. Modulo example

13.5.5 Monitoring transfer descriptor status

This section discusses how to monitor eDMA status.

Testing for minor loop completion 13.5.5.1

There are two methods to test for minor loop completion when using software initiated service requests. The first is to read the TCDn_CITER field and test for a change. Another method may be extracted from the sequence shown below. The second method is to test the TCDn_CSR[START] bit and the TCDn_CSR[ACTIVE] bit. The minor-loopcomplete condition is indicated by both bits reading zero after the TCDn_CSR[START] was set. Polling the TCDn CSR[ACTIVE] bit may be inconclusive, because the active status may be missed if the channel execution is short in duration.

The TCD status bits execute the following sequence for a software activated channel:

Stage		TCDn_CSR bits		State	
Stage	START	ACTIVE	DONE		
1	1	0	0	Channel service request via software	
2	0	1	0	Channel is executing	
3a	0	0	0	Channel has completed the minor loop and is idle	
3b	0	0	1	Channel has completed the major loop and is idle	

The best method to test for minor-loop completion when using hardware, that is, peripheral, initiated service requests is to read the TCD*n*_CITER field and test for a change. The hardware request and acknowledge handshake signals are not visible in the programmer's model.

The TCD status bits execute the following sequence for a hardware-activated channel:

Stone	TCDn_CSR bits			State
Stage	Stage START	ACTIVE	DONE	State
1	0	0	0	Channel service request via hardware (peripheral request asserted)
2	0	1	0	Channel is executing
3a	0	0	0	Channel has completed the minor loop and is idle
3b	0	0	1	Channel has completed the major loop and is idle

For both activation types, the major-loop-complete status is explicitly indicated via the TCD*n*_CSR[DONE] bit.

The $TCDn_CSR[START]$ bit is cleared automatically when the channel begins execution regardless of how the channel activates.

13.5.5.2 Reading the transfer descriptors of active channels

The eDMA reads back the true TCD*n*_SADDR, TCD*n*_DADDR, and TCD*n*_NBYTES values if read while a channel executes. The true values of the SADDR, DADDR, and NBYTES are the values the eDMA engine currently uses in its internal register file and not the values in the TCD local memory for that channel. The addresses, SADDR and DADDR, and NBYTES, which decrement to zero as the transfer progresses, can give an indication of the progress of the transfer. All other values are read back from the TCD local memory.

NXP Semiconductors

259

13.5.5.3 Checking channel preemption status

Preemption is available only when fixed arbitration is selected as the channel arbitration mode. A preemptive situation is one in which a preempt-enabled channel runs and a higher priority request becomes active. When the eDMA engine is not operating in fixed channel arbitration mode, the determination of the actively running relative priority outstanding requests become undefined. Channel priorities are treated as equal, that is, constantly rotating, when Round-Robin Arbitration mode is selected.

The TCD*n*_CSR[ACTIVE] bit for the preempted channel remains asserted throughout the preemption. The preempted channel is temporarily suspended while the preempting channel executes one major loop iteration. If two TCD*n*_CSR[ACTIVE] bits are set simultaneously in the global TCD map, a higher priority channel is actively preempting a lower priority channel.

13.5.6 Channel Linking

Channel linking (or chaining) is a mechanism where one channel sets the TCD*n*_CSR[START] bit of another channel (or itself), therefore initiating a service request for that channel. When properly enabled, the EDMA engine automatically performs this operation at the major or minor loop completion.

The minor loop channel linking occurs at the completion of the minor loop (or one iteration of the major loop). The TCDn_CITER[E_LINK] field determines whether a minor loop link is requested. When enabled, the channel link is made after each iteration of the major loop except for the last. When the major loop is exhausted, only the major loop channel link fields are used to determine if a channel link should be made. For example, the initial fields of:

```
TCDn_CITER[E_LINK] = 1
TCDn_CITER[LINKCH] = 0xC
TCDn_CITER[CITER] value = 0x4
TCDn_CSR[MAJOR_E_LINK] = 1
TCDn_CSR[MAJOR_LINKCH] = 0x7
```

executes as:

- 1. Minor loop done \rightarrow set TCD12_CSR[START] bit
- 2. Minor loop done \rightarrow set TCD12_CSR[START] bit
- 3. Minor loop done \rightarrow set TCD12_CSR[START] bit
- 4. Minor loop done, major loop done→ set TCD7_CSR[START] bit

When minor loop linking is enabled (TCDn_CITER[E_LINK] = 1), the TCDn_CITER[CITER] field uses a nine bit vector to form the current iteration count. When minor loop linking is disabled (TCDn_CITER[E_LINK] = 0), the TCDn_CITER[CITER] field uses a 15-bit vector to form the current iteration count. The bits associated with the TCDn_CITER[LINKCH] field are concatenated onto the CITER value to increase the range of the CITER.

Note

The TCD*n*_CITER[E_LINK] bit and the TCD*n*_BITER[E_LINK] bit must equal or a configuration error is reported. The CITER and BITER vector widths must be equal to calculate the major loop, half-way done interrupt point.

The following table summarizes how a DMA channel can link to another DMA channel, i.e, use another channel's TCD, at the end of a loop.

Desired Link Behavior	TCD Control Field Name	Description
Link at end of Minor Loop	CITER[E_LINK]	Enable channel-to-channel linking on minor loop completion (current iteration)
Willion Loop	CITER[LINKCH]	Link channel number when linking at end of minor loop (current iteration)
Link at end of Major Loop	CSR[MAJOR_E_LINK]	Enable channel-to-channel linking on major loop completion
	CSR[MAJOR_LINKCH]	Link channel number when linking at end of major loop

Table 13-10. Channel Linking Parameters

13.5.7 Dynamic programming

This section provides recommended methods to change the programming model during channel execution.

13.5.7.1 Dynamically changing the channel priority

The following two options are recommended for dynamically changing channel priority levels:

- 1. Switch to Round-Robin Channel Arbitration mode, change the channel priorities, then switch back to Fixed Arbitration mode,
- 2. Disable all the channels, change the channel priorities, then enable the appropriate channels.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

13.5.7.2 Dynamic channel linking

Dynamic channel linking is the process of setting the TCD.major.e_link bit during channel execution (see the diagram in TCD structure). This bit is read from the TCD local memory at the end of channel execution, thus allowing the user to enable the feature during channel execution.

Because the user is allowed to change the configuration during execution, a coherency model is needed. Consider the scenario where the user attempts to execute a dynamic channel link by enabling the TCD.major.e_link bit at the same time the eDMA engine is retiring the channel. The TCD.major.e_link would be set in the programmer's model, but it would be unclear whether the actual link was made before the channel retired.

The following coherency model is recommended when executing a dynamic channel link request.

- 1. Write 1 to the TCD.major.e_link bit.
- 2. Read back the TCD.major.e_link bit.
- 3. Test the TCD.major.e_link request status:
 - If TCD.major.e_link = 1, the dynamic link attempt was successful.
 - If TCD.major.e_link = 0, the attempted dynamic link did not succeed (the channel was already retiring).

For this request, the TCD local memory controller forces the TCD.major.e_link bit to zero on any writes to a channel's TCD.word7 after that channel's TCD.done bit is set, indicating the major loop is complete.

NOTE

The user must clear the TCD.done bit before writing the TCD.major.e_link bit. The TCD.done bit is cleared automatically by the eDMA engine after a channel begins execution.

13.5.7.3 Dynamic scatter/gather

Scatter/gather is the process of automatically loading a new TCD into a channel. It allows a DMA channel to use multiple TCDs; this enables a DMA channel to scatter the DMA data to multiple destinations or gather it from multiple sources. When scatter/gather is enabled and the channel has finished its major loop, a new TCD is fetched from system memory and loaded into that channel's descriptor location in eDMA programmer's model, thus replacing the current descriptor.

Because the user is allowed to change the configuration during execution, a coherency model is needed. Consider the scenario where the user attempts to execute a dynamic scatter/gather operation by enabling the TCD.e_sg bit at the same time the eDMA engine is retiring the channel. The TCD.e_sg would be set in the programmer's model, but it would be unclear whether the actual scatter/gather request was honored before the channel retired.

Two methods for this coherency model are shown in the following subsections. Method 1 has the advantage of reading the major.linkch field and the e_sg bit with a single read. For both dynamic channel linking and scatter/gather requests, the TCD local memory controller forces the TCD.major.e_link and TCD.e_sg bits to zero on any writes to a channel's TCD.word7 if that channel's TCD.done bit is set indicating the major loop is complete.

NOTE

The user must clear the TCD.done bit before writing the TCD.major.e_link or TCD.e_sg bits. The TCD.done bit is cleared automatically by the eDMA engine after a channel begins execution.

13.5.7.3.1 Method 1 (channel not using major loop channel linking)

For a channel not using major loop channel linking, the coherency model described here may be used for a dynamic scatter/gather request.

When the TCD.major.e_link bit is zero, the TCD.major.linkch field is not used by the eDMA. In this case, the TCD.major.linkch bits may be used for other purposes. This method uses the TCD.major.linkch field as a TCD indentification (ID).

- 1. When the descriptors are built, write a unique TCD ID in the TCD.major.linkch field for each TCD associated with a channel using dynamic scatter/gather.
- 2. Write 1b to the TCD.d_req bit.
 - Should a dynamic scatter/gather attempt fail, setting the TCD.d_req bit will prevent a future hardware activation of this channel. This stops the channel from executing with a destination address (daddr) that was calculated using a scatter/gather address (written in the next step) instead of a dlast final offest value.
- 3. Write the TCD.dlast_sga field with the scatter/gather address.
- 4. Write 1b to the TCD.e_sg bit.
- 5. Read back the 16 bit TCD control/status field.

NXP Semiconductors

263

Initialization/application information

6. Test the TCD.e_sg request status and TCD.major.linkch value:

If $e_sg = 1b$, the dynamic link attempt was successful.

If e_sg = 0b and the major.linkch (ID) did not change, the attempted dynamic link did not succeed (the channel was already retiring).

If e_sg = 0b and the major.linkch (ID) changed, the dynamic link attempt was successful (the new TCD's e_sg value cleared the e_sg bit).

13.5.7.3.2 Method 2 (channel using major loop channel linking)

For a channel using major loop channel linking, the coherency model described here may be used for a dynamic scatter/gather request. This method uses the TCD.dlast_sga field as a TCD indentification (ID).

1. Write 1b to the TCD.d_req bit.

Should a dynamic scatter/gather attempt fail, setting the d_req bit will prevent a future hardware activation of this channel. This stops the channel from executing with a destination address (daddr) that was calculated using a scatter/gather address (written in the next step) instead of a dlast final offest value.

- 2. Write the TCD.dlast_sga field with the scatter/gather address.
- 3. Write 1b to the TCD.e_sg bit.
- 4. Read back the TCD.e_sg bit.
- 5. Test the TCD.e_sg request status:

If $e_sg = 1b$, the dynamic link attempt was successful.

If e_sg = 0b, read the 32 bit TCD dlast_sga field.

If e_sg = 0b and the dlast_sga did not change, the attempted dynamic link did not succeed (the channel was already retiring).

If e_sg = 0b and the dlast_sga changed, the dynamic link attempt was successful (the new TCD's e_sg value cleared the e_sg bit).

13.5.8 Suspend/resume a DMA channel with active hardware service requests

The DMA allows the user to move data from memory or peripheral registers to another location in memory or peripheral registers without CPU interaction. Once the DMA and peripherals have been configured and are active, it is rare to suspend a peripheral's service request dynamically. In this scenario, there are certain restrictions to disabling a DMA hardware service request. For coherency, a specific procedure must be followed. This section provides guidance on how to coherently suspend and resume a Direct Memory Access (DMA) channel when the DMA is triggered by a slave module such as the Serial Peripheral Interface (SPI), ADC, or other module.

13.5.8.1 Suspend an active DMA channel

To suspend an active DMA channel:

- 1. Stop the DMA service request at the peripheral first. Confirm it has been disabled by reading back the appropriate register in the peripheral.
- 2. Check Hardware Request Status Register (DMA_HRS) to ensure there is no service request to the DMA channel being suspended. Then disable the hardware service request by clearing the ERQ bit on the appropriate DMA channel.

13.5.8.2 Resume a DMA channel

To resume a DMA channel:

- 1. Enable the DMA service request on the appropriate channel by setting its ERQ bit.
- 2. Enable the DMA service request at the peripheral.

For example, assume a SPI module is set as a master for transmitting data via a DMA service request when the SPI TXFIFO has an empty slot. The DMA will transfer the next command and data to the TXFIFO upon the request. If the user needs to suspend the DMA/SPI transfer loop, perform the following steps:

- 1. Disable the DMA service request at the source by writing 0 to SPI_RSER[TFFF_RE]. Confirm that SPI_RSER[TFFF_RE] is 0.
- 2. Ensure there is no DMA service request from the SPI by verifying that DMA_HRS[HRSn] is 0 for the appropriate channel. If no service request is present, disable the DMA channel by clearing the channel's ERQ bit. If a service request is present, wait until the request has been processed and the HRS bit reads zero.

NXP Semiconductors

265

13.6 Usage Guide

NOTE

User should configure DMA_TCD*n*_CSR[BWC] (bit 15-14) as 10 when another DMA channel is active.

Related application notes on this DMA module are as follows.

- Using DMA for pulse counting on Kinetis
- Using DMA and GPIO to emulate timer functionality on Kinetis Family devices
- Using DMA to Emulate ADC Flexible Scan Mode on Kinetis K Series

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

NXP Semiconductors

Chapter 14 Memory and memory map

14.1 Introduction

This device contains various memories and memory-mapped peripherals which are located in one 4G bytes (32-bit address) contiguous memory space. This chapter describes the memory and peripheral locations within that memory space.

The following figure shows the system memory and peripheral locations.

Introduction 0x4000_0000 AIPS-Lite 0x4000_1000 Reserved 0x4000_2000 Reserved Note: 0x4000_8000 eDMA The size of Flash and SRAM varies for 0x4000_9000 DMA TCD devices with different part numbers. 0x4000_A000 See "Ordering information" in DataSheet for details. 0x4000_F000 GPIO controller(aliased to 400F_F000) 0x4001_0000 0x0000_0000 0x4002_0000 Flash * Flash memory unit 0x4002_1000 0x0003_FFFF DMAMUX0 0x4002_2000 0x0000_0000 0x07FF_FFFF 0x4002_7000 ADC1 Code space 0x4002_8000 0x0800_0000 0x4002_C000 LPSPI0 0x1000_0000 0x4002 D000 LPSPI1 FlexNVM 0x4002_E000 0x1000_8000 Reserved 0x4003_2000 CRC 0x1400_0000 FlexRAM 0x4003_3000 0x1400_0800 0x4003_6000 Reserved PDB0 0x1800_0000 0x1C00_0000 0x4003_7000 LPIT0 0x1C00_0000 0x4003_8000 FTM0 ROM 0x4003_9000 FTM1 Boot ROM 0x4003_A000 FTM2 0x1C00_3FFF 0x4003_B000 ADC0 0x1C00_4000 0x4003_C000 0x1FF0_0000 0x4003 D000 0x1FF0_0000 RTC Data Space SRAM_L 0x4003_E000 0x2000_0000 0x2010 0000 0x4004_0000 LPTMR0 SRAM_U 0x200F_FFFF 0x2200_0000 Aliased to SRAM_U 0x4004_1000 bit-band region 0x4004_5000 0x2400_0000 TSI0 0x4004_6000 0x4000_0000 0x4004_8000 SIM **Public** 0x4004_9000 **PORT A** 0x4000_0000 peripheral 0x4004 A000 PORT B **AIPS** 0x4004_B000 PORT C 0x4010_0000 peripherals 0x4004_C000 Reserved PORT D 0x4400_0000 0x4004_D000 PORT E 0x4008_0000 BME 0x4004_E000 0x4005_2000 GPIO WDOG 0x6000_0000 0x4005_3000 Reserved 0xE000_0000 0x4005_6000 PWT 0xE000_E000 0x4005_7000 0xE000 0000 Reserved System 0x4005_A000 FlexIO0 control 0x4005_B000 **Private** space 0x4006_0000 peripheral OSC32 0xE000_F000 0x4006_1000 **FWM** 0x4006_2000 TRGMUX 0xE00F_F000 0xE010_0000 Core 0x4006_3000 TRGMUX1 **ROM** table 0x4006_4000 0xE00F_FFFF SCG 0x4006_5000 0xF000_0000 PCC MTB 0x4006 6000 LPI2C0 0xF000_1000 0x4006 7000 MTRDWT 0xF000_0000 LPI2C1 0x4006 8000 0xF000_2000 0x4006_A000 LPUART0 **ROM Table** Private 0x4006_B000 0xF000_3000 LPUART1 peripheral MCM 0x4006_C000 LPUART2 bus 0x4006_D000 0xF000 4000 MMDVSQ 0x4007_3000 CMP0 0xF000_5000 0x4007_4000 CMP1 0xFFFF_FFFF 0x4007_5000 Reserved 0xF800_0000 0x4007_D000 PMC **IOPORT** 0x4007_E000 0xFFFF_FFF SMC 0x4007_F000 **RCM** 0x4007_FFFF

Figure 14-1. Memory map

14.2 Flash memory

14.2.1 Flash memory types

This device contains the following types of flash memory:

- Program flash memory non-volatile flash memory that can execute program code
- FlexMemory encompasses the following memory types:
 - FlexNVM Non-volatile flash memory that can execute program code, store data, or backup EEPROM data
 - FlexRAM RAM memory that can be used as traditional RAM or as highendurance EEPROM storage, and also accelerates flash programming

14.2.2 Flash Memory Sizes

The devices covered in this document contain:

- 1 block (256 KB) of program flash consisting of 2 KB sectors
- 1 block (32 KB) of FlexNVM consisting of 2 KB sectors
- 1 block (2 KB) of FlexRAM

The amounts of flash memory and the address range for the devices is shown in following table.

Device	Program flash (KB)	FlexNVM (KB)	FlexRAM (KB)	Address range
KE1xZ256VLL7	256	32	2	0x0000_0000-0x0003_FFFF (P-Flash)
				0x1000_0000-0x1000_7FFF (FlexNVM)
				0x1400_0000-0x1400_07FF (FlexRAM)
KE1xZ256VLH7	256	32	2	0x0000_0000-0x0003_FFFF (P-Flash)
				0x1000_0000-0x1000_7FFF (FlexNVM)
				0x1400_0000-0x1400_07FF (FlexRAM)
KE1xZ128VLL7	128	32	2	0x0000_0000-0x0001_FFFF (P-Flash)
				0x1000_0000-0x1000_7FFF (FlexNVM)
				0x1400_0000-0x1400_07FF (FlexRAM)
KE1xZ128VLH7	128	32	2	0x0000_0000-0x0001_FFFF (P-Flash)
				0x1000_0000-0x1000_7FFF (FlexNVM)
				0x1400_0000-0x1400_07FF (FlexRAM)

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018 **NXP Semiconductors** 269

14.3 SRAM memory

14.3.1 SRAM sizes

This device contains SRAM accessed by bus masters through the cross-bar switch. The on-chip SRAM is split into SRAM_L and SRAM_U regions where the SRAM_L and SRAM_U ranges form a contiguous block in the memory map anchored at address 0x2000_0000. As such:

- SRAM_L is anchored to 0x1FFF_FFFF and occupies the space before this ending address.
- SRAM_U is anchored to 0x2000_0000 and occupies the space after this beginning address.

NOTE

Burst-access cannot occur across the 0x2000_0000 boundary that separates the two SRAM arrays. The two arrays should be treated as separate memory ranges for burst accesses.

The amount of SRAM for the devices covered in this document is shown in the following table.

Device	SRAM_L size (KB)	SRAM_U size (KB)	Total SRAM (KB)	Address Range
MKE1xZ256Vxx7	8	24	32	0x1FFF_E000-0x2000_5FFF
MKE1xZ128Vxx7	4	12	16	0x1FFF_F000-0x2000_2FFF

14.3.2 SRAM retention in low power modes

The SRAM is retained power on to all power modes on this device.

14.4 System memory map

The following table shows the high-level device memory map. This map provides the complete architectural address space definition for the various sections. Based on the physical sizes of the memories and peripherals, the actual address regions used may be smaller.

Table 14-1. System memory map

System 32-bit Address Range	Destination Slave	Access
0x0000_0000-0x07FF_FFFF ¹	Program flash and read-only data	All masters
	(Includes exception vectors in first 1024 bytes)	
0x0800_0000-0x0FFF_FFF	Reserved	_
0x1000_0000-0x13FF_FFFF	FlexNVM	All masters
0x1400_0000-0x17FF_FFFF	FlexRAM	All masters
0x1800_0000-0x1BFF_FFFF	Reserved	_
0x1C00_0000-0x1C00_3FFF	Boot ROM	Cortex-M0+ core only
0x1C00_4000-0x1FEF_FFFF	Reserved	_
0x1FF0_0000-0x1FFF_FFFF ²	SRAM_L: Lower SRAM	All masters
0x2000_0000-0x200F_FFFF ²	SRAM_U: Upper SRAM bitband region	All masters
0x2010_0000-0x201F_FFFF	Reserved	_
0x2020_0000-0x21FF_FFFF	Reserved	_
0x2200_0000-0x23FF_FFFF	Aliased SRAM_U bit-band region	Cortex-M0+ core only
0x2400_0000-0x2FFF_FFFF	Reserved	_
0x3000_0000-0x33FF_FFFF	Reserved	_
0x3400_0000-0x3FFF_FFFF	Reserved	_
0x4000_0000-0x4007_FFFF	AIPS Peripherals	Cortex-M0+ core & DMA
0x4008_0000-0x400F_EFFF	Reserved	_
0x400F_F000-0x400F_FFFF	General purpose input/output (GPIO)	Cortex-M0+ core & DMA
0x4010_0000-0x41FF_FFFF	Reserved	_
0x4200_0000-0x43FF_FFFF	Reserved	_
0x4400_0000-0x5FFF_FFFF	Bit Manipulation Engine (BME) access to AIPS Peripherals for slots 0-127	Cortex-M0+ core only
0x6000_0000-0xDFFF_FFF	Reserved	_
0xE000_0000-0xE00F_FFFF	Private peripherals	Cortex-M0+ core only
0xE010_0000-0xEFFF_FFF	Reserved	_
0xF000_0000-0xF000_0FFF	Micro Trace Buffer (MTB) registers	Cortex-M0+ core only
0xF000_1000-0xF000_1FFF	MTB Data Watchpoint and Trace (MTBDWT) registers	Cortex-M0+ core only
0xF000_2000-0xF000_2FFF	ROM table	Cortex-M0+ core only
0xF000_3000-0xF000_3FFF	Miscellaneous Control Module (MCM)	Cortex-M0+ core only
0xF000_4000-0xF000_4FFF	Memory Mapped Divide and Square Root (MMDVSQ)	Cortex-M0+ core only
0xF000_5000-0xF7FF_FFF	Reserved	_
		1

Table continues on the next page...

System memory map

Table 14-1. System memory map (continued)

System 32-bit Address Range	Destination Slave	Access
0xF800_0000-0xFFFF_FFF	IOPORT: RGPIO (single cycle)	Cortex-M0+ core only

- This map provides the complete architectural address space definition for the flash. Based on the physical sizes of the memories implemented for a particular device, the actual address regions used may be smaller. See Flash Memory Sizes for details
- 2. This range varies depending on amount of SRAM implemented for a particular device. See SRAM sizes for details.

NOTE

- 1. Access rights to AIPS-Lite peripheral bridge and general purpose input/output (GPIO) module address space is limited to the core, DMA.
- 2. The SRAM on this device could be accessed through normal way with 32-bit operation, and also could be accessed with bit operation through aliased bit-band region.

14.4.1 Aliased bit-band regions

The device supports aliased SRAM_U bit-band region with Cortex M0+ core. A 32-bit write in the alias region has the same result as a read-modify-write operation on the targeted bit in the bit-band region, but with only one cycle time. Aliased bit-band region is much more efficient for bit operation.

Bit 0 of the value written to the alias region determines what value is written to the target bit:

- Writing a value with bit 0 set writes a 1 to the target bit.
- Writing a value with bit 0 clear writes a 0 to the target bit.

A 32-bit read in the alias region returns either:

- a value of 0x0000_0000 to indicate the target bit is clear
- a value of 0x0000_0001 to indicate the target bit is set

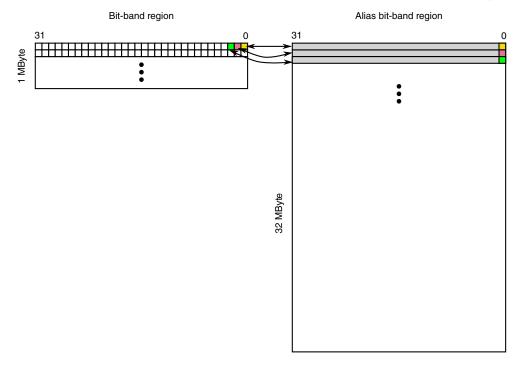


Figure 14-2. Alias bit-band mapping

NOTE

Each bit in bit-band region has an equivalent bit that can be manipulated through bit 0 in a corresponding long word in the alias bit-band region.

14.4.2 Bit Manipulation Engine

The Bit Manipulation Engine (BME) provides hardware support for atomic read-modify-write memory operations to the peripheral address space. By combining the basic load and store instruction support in the Cortex-M instruction set architecture with the concept of decorated storage provided by the BME, the resulting implementation provides a robust and efficient read-modify-write capability to this class of ultra low-end microcontrollers. See the Bit Manipulation Engine Block Guide (BME) for a detailed description of BME functionality.

14.5 Peripheral memory map

The peripheral memory map is accessible via a crossbar slave port and the AIPS peripheral bridge. The peripheral bridge converts register access from AHB bus domain to peripheral bus domain.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Peripheral memory map

For peripherals that have clock gating control bits (CGC bit) in PCC module, the associated peripherals could be enabled/disabled by these control bits. Access to a disabled peripheral or unimplemented AIPS slot results in a transfer error termination.

For programming model accesses via the peripheral bridges, there is generally only a small range within the 4 KB slots that is implemented. Accessing an address that is not implemented in the peripheral results in a transfer error termination.

14.5.1 Peripheral Bridge (AIPS-Lite) Memory Map

Table 14-2. Peripheral bridge slot assignments

System 32-bit base address	Slot number	Module
0x4000_0000	0	
0x4000_1000	1	MSCM
0x4000_2000	2	_
0x4000_3000	3	_
0x4000_4000	4	_
0x4000_5000	5	_
0x4000_6000	6	_
0x4000_7000	7	_
0x4000_8000	8	DMA controller
0x4000_9000	9	DMA controller transfer control descriptors
0x4000_A000	10	_
0x4000_B000	11	_
0x4000_C000	12	_
0x4000_D000	13	_
0x4000_E000	14	_
0x4000_F000	15	RGPIO controller (aliased to 0x400F_F000)
0x4001_0000	16	_
0x4001_1000	17	_
0x4001_2000	18	_
0x4001_3000	19	_
0x4001_4000	20	_
0x4001_5000	21	_
0x4001_6000	22	_
0x4001_7000	23	_
0x4001_8000	24	_
0x4001_9000	25	_
0x4001_A000	26	_
0x4001_B000	27	_

Table continues on the next page...

Table 14-2. Peripheral bridge slot assignments (continued)

System 32-bit base address	Slot number	Module
0x4001_C000	28	_
0x4001_D000	29	_
0x4001_E000	30	_
0x4001_F000	31	_
0x4002_0000	32	Flash memory
0x4002_1000	33	DMA channel mutiplexer 0
0x4002_2000	34	_
0x4002_3000	35	_
0x4002_4000	36	_
0x4002_5000	37	_
0x4002_6000	38	_
0x4002_7000	39	Analog-to-digital converter (ADC) 1
0x4002_8000	40	_
0x4002_9000	41	_
0x4002_A000	42	_
0x4002_B000	43	_
0x4002_C000	44	Low Power SPI (LPSPI) 0
0x4002_D000	45	Low Power SPI (LPSPI) 1
0x4002_E000	46	_
0x4002_F000	47	_
0x4003_0000	48	_
0x4003_1000	49	_
0x4003_2000	50	CRC
0x4003_3000	51	_
0x4003_4000	52	_
0x4003_5000	53	_
0x4003_6000	54	Programmable delay block (PDB) 0
0x4003_7000	55	Low-power Periodic interrupt timer (LPIT0)
0x4003_8000	56	FlexTimer (FTM) 0
0x4003_9000	57	FlexTimer (FTM) 1
0x4003_A000	58	FlexTimer (FTM) 2
0x4003_B000	59	Analog-to-digital converter (ADC) 0
0x4003_C000	60	_
0x4003_D000	61	Real-time clock (RTC)
0x4003_E000	62	
0x4003_F000	63	
0x4004_0000	64	Low-power timer (LPTMR0)
0x4004_1000	65	
0x4004_2000	66	

Table continues on the next page...

Peripheral memory map

Table 14-2. Peripheral bridge slot assignments (continued)

System 32-bit base address	Slot number	Module
0x4004_3000	67	_
0x4004_4000	68	_
0x4004_5000	69	Touch sense interface (TSI)
0x4004_6000	70	_
0x4004_7000	71	_
0x4004_8000	72	System integration module (SIM)
0x4004_9000	73	Port A multiplexing control
0x4004_A000	74	Port B multiplexing control
0x4004_B000	75	Port C multiplexing control
0x4004_C000	76	Port D multiplexing control
0x4004_D000	77	Port E multiplexing control
0x4004_E000	78	_
0x4004_F000	79	_
0x4005_0000	80	_
0x4005_1000	81	_
0x4005_2000	82	Software watchdog (WDOG)
0x4005_3000	83	_
0x4005_4000	84	
0x4005_5000	85	_
0x4005_6000	86	Pulse Width Timer (PWT)
0x4005_7000	87	_
0x4005_8000	88	_
0x4005_9000	89	_
0x4005_A000	90	Flexible IO (FlexIO)
0x4005_B000	91	_
0x4005_C000	92	_
0x4005_D000	93	_
0x4005_E000	94	_
0x4005_F000	95	_
0x4006_0000	96	OSC32
0x4006_1000	97	External watchdog (EWM)
0x4006_2000	98	Trigger Multiplexing Control (TRGMUX 0)
0x4006_3000	99	Trigger Multiplexing Control (TRGMUX 1)
0x4006_4000	100	System Clock Generator (SCG)
0x4006_5000	101	Peripheral Clock Control (PCC)
0x4006_6000	102	Low Power I ² C (LPI ² C 0)
0x4006_7000	103	Low Power I ² C (LPI ² C 1)
0x4006_8000	104	_
0x4006_9000	105	_

Table continues on the next page...

Table 14-2. Peripheral bridge slot assignments (continued)

System 32-bit base address	Slot number	Module
0x4006_A000	106	Low Power UART (LPUART 0)
0x4006_B000	107	Low Power UART (LPUART 1)
0x4006_C000	108	Low Power UART (LPUART 2)
0x4006_D000	109	_
0x4006_E000	110	_
0x4006_F000	111	_
0x4007_0000	112	_
0x4007_1000	113	_
0x4007_2000	114	_
0x4007_3000	115	Analog comparator (CMP 0)
0x4007_4000	116	Analog comparator (CMP 1)
0x4007_5000	117	_
0x4007_6000	118	_
0x4007_7000	119	_
0x4007_8000	120	_
0x4007_9000	121	_
0x4007_A000	122	_
0x4007_B000	123	_
0x4007_C000	124	_
0x4007_D000	125	Power management controller (PMC)
0x4007_E000	126	System Mode controller (SMC)
0x4007_F000	127	Reset Control Module (RCM)
0x400F_F000		GPIO controller

14.6 Private Peripheral Bus (PPB) memory map

The PPB is part of the defined ARM bus architecture and provides access to select processor-local modules. These resources are only accessible from the core; other system masters do not have access to them.

Table 14-3. PPB memory map

System 32-bit Address Range	Resource	Additional Range Detail	Resource
0xE000_0000-0xE000_DFFF	Reserved		
0xE000_E000-0xE000_EFFF	(SCS)	0xE000_E000-0xE000_E00F	Reserved
		0xE000_E010-0xE000_E0FF	SysTick
		0xE000_E100-0xE000_ECFF	NVIC

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Private Peripheral Bus (PPB) memory map

Table 14-3. PPB memory map (continued)

System 32-bit Address Range	Resource	Additional Range Detail	Resource
		0xE000_ED00-0xE000_ED8F	System Control Block
		0xE000_ED90-0xE000_EDEF	Reserved
		0xE000_EDF0-0xE000_EEFF	Debug
		0xE000_EF00-0xE000_EFFF	Reserved
0xE000_F000-0xE00F_EFFF	Reserved		
0xE00F_F000-0xE00F_FFFF	Core ROM Space (CRS)		

Chapter 15 Flash Acceleration Unit (FAU)

15.1 Flash Acceleration Unit (FAU)

15.1.1 Introduction

The Flash Acceleration Unit (FAU) is a memory acceleration unit. It includes a buffer and a cache that can accelerate program flash memory data transfers. In addition, this module provides two separate mechanisms for accelerating the interface between bus masters and program flash memory. A 64-bit speculation buffer can prefetch the next 64-bit flash memory location, and a 4-way, 4-set program flash memory cache can store previously accessed program flash memory data for quick access times.

15.1.2 Modes of operation

The FAU operates only when a bus master accesses the program flash memory or FlexMemory.

In terms of chip power modes:

- The FAU operates only in Run and Wait modes, including VLPR and VLPW modes.
- For any power mode where the program flash memory or FlexMemory cannot be accessed, the FAU is disabled.

15.1.3 External signal description

The FAU has no external (off-chip) signals.

15.1.4 Memory map and register descriptions

The MCM's programming model provides control and configuration of the FAU's features. For details, see the description of the MCM's Platform Control Register (PLACR).

15.1.5 Functional description

The FAU is a flash acceleration unit with flexible buffers for user configuration.

Besides managing the interface between bus masters and the program flash memory and FlexMemory, the FAU can be used to customize the program flash memory cache and buffer to provide single-cycle system clock data access times. Whenever a hit occurs for the prefetch speculation buffer or the cache (when enabled), the requested data is transferred within a single system clock.

Upon system reset, the FAU is configured as follows:

- Flash cache is enabled.
- Instruction speculation and caching are enabled.
- Data speculation is disabled.
- Data caching is enabled.

Though the default configuration provides flash acceleration, advanced users may desire to customize the FAU buffer configurations to maximize throughput for their use cases. For example, the user may adjust the controls to enable buffering per access type (data or instruction).

NOTE

When reconfiguring the FAU, do not program the control and configuration inputs to the FAU while the program flash memory or FlexMemory is being accessed. Instead, change them with a routine executing from RAM in supervisor mode.

15.2 Usage Guide

For many systems the on-chip flash is the main memory. The Flash Acceleration Unit (FAU) is the interface between the flash memory blocks and the system. In a typical configuration, the core and system bus clock speeds are clock significantly faster than the flash memory clock. The FAU includes features designed to accelerate flash accesses.

For more detailed information, refer to the FMC (same module as FAU) section in AN4745: Optimizing Performance on Kinetis K-series MCUs.

15.2.1 **FAU Features**

The FAU has two key features that help to increase the chance that flash accesses can be serviced in a single clock cycle:

- FAU cache There is a small cache within the FAU that stores recently accessed flash information. The exact configuration of the FAU cache can vary from device to device, but an FAU cache is present on all devices. Note: some Kinetis devices also contain a system cache that is completely separate from the FAU cache. The two caches operate independently, but can be used together to help accelerate flash reads.
- Prefetch speculation buffer As memory accesses are usually sequential, when the FAU receives a request for a given flash location, the FAU will prefetch the next consecutive flash data chunk. Prefetched information is stored in the prefetch speculation buffer until a request to a different data chunk is received.

The FAU cache and prefetch speculation buffer allow the FAU to respond to flash accesses with no added wait states in many cases. Any time the requested information is available in the cache or prefetch buffer, the FAU responds with no added wait states.

15.2.2 **FAU Configuration**

The FAU cache and prefetch buffers are enabled by default. Most applications will not require any reconfiguration of the FAU for optimal performance.

There are some programmable options that could be changed:

- Instruction vs. data cache By default both instructions and data accesses are cached. This can be changed so that the entire FAU cache is used for instructions only or data only. The FAU cache could also be disabled entirely by turning off both instruction and data caching, but this setting is not recommended when trying to increase performance.
- Instruction vs. data prefetching By default both instructions and data accesses can trigger a speculative prefetch cycle.

This can be changed so that only instructions or only data accesses initiate a speculative prefetch. Instruction only prefetching might be desired if random data accesses are mixed in with mostly sequential instruction accesses to the same bank of flash.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Usage Guide

- Cache locking Each of the four ways in the FAU cache can be locked to force the cache to keep some values. The FAU cache is small, so usually it is a better option to move critical code or data to one of the SRAM blocks (preferrably SRAM_L) instead of locking the FAU cache. This way the critical information is available with no wait states and the entire FAU cache is still available for acceleration of flash accesses.
- Cache replacement control The FAU cache replacement algorithm can be modified from the default setting where instruction and data are handled the same so that ways 0-1 or ways 0-2 are dedicated for instructions and remaining ways are used for data.

NOTE

The FAU registers should not be modified while accessing the flash. It is recommended executing any code that modifies the FAU settings from the on-chip SRAM.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Chapter 16 Flash Memory Module (FTFE)

16.1 Chip-specific Information for this Module

The chip-specific Flash information is as below. See the "Ordering information" section and the cover-page "Memory and memory interfaces" feature list in DataSheet for more information.

- Program Flash = 256 or 128 KB
- SRAM = 32 or 16 KB
- FlexNVM = 32 KB
- FlexRAM = 2 KB

NOTE

For device with BootROM, the flash driver is exported from ROM for customer use. Please visit http://www.nxp.com/kboot for more information.

16.2 Introduction

The FTFE module includes the following accessible memory regions:

- Program flash memory for vector space and code store
- FlexNVM for data store and additional code store
- FlexRAM for high-endurance data store or traditional RAM

Flash memory is ideal for single-supply applications, permitting in-the-field erase and reprogramming operations without the need for any external high voltage power sources.

Introduction

The FTFE module includes a memory controller that executes commands to modify flash memory contents. An erased bit reads '1' and a programmed bit reads '0'. The programming operation is unidirectional; it can only move bits from the '1' state (erased) to the '0' state (programmed). Only the erase operation restores bits from '0' to '1'; bits cannot be programmed from a '0' to a '1'.

CAUTION

A flash memory location must be in the erased state before being programmed. Cumulative programming of bits (back-toback program operations without an intervening erase) within a flash memory location is not allowed. Re-programming of existing 0s to 0 is not allowed as this overstresses the device.

The standard shipping condition for flash memory is erased with security disabled. Data loss over time may occur due to degradation of the erased ('1') states and/or programmed ('0') states. Therefore, it is recommended that each flash block or sector be re-erased immediately prior to factory programming to ensure that the full data retention capability is achieved.

16.2.1 Features

The FTFE module includes the following features.

NOTE

See Memories and Memory Interfaces chapter for the exact amount of flash memory available on your device.

16.2.1.1 Program Flash Memory Features

- Sector size of 2 Kbytes
- Program flash protection scheme prevents accidental program or erase of stored data
- Program flash access control scheme prevents unauthorized access to selected code segments
- · Automated, built-in, program and erase algorithms with verify
- Section programming for faster bulk programming times
- Read access to the program flash block is possible while programming or erasing data in the data flash block or FlexRAM

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

285

16.2.1.2 FlexNVM memory features

When FlexNVM is partitioned for data flash memory:

- Sector size of 2 Kbytes
- Protection scheme prevents accidental program or erase of stored data
- Automated, built-in program and erase algorithms with verify
- Section programming for faster bulk programming times
- Read access to the data flash block possible while programming or erasing data in the program flash block

16.2.1.3 FlexRAM features

- Memory that can be used as traditional RAM or as high-endurance EEPROM storage
- Up to 2 Kbytes of FlexRAM configured for EEPROM or traditional RAM operations
- When configured for EEPROM:
 - Protection scheme prevents accidental program or erase of data written for EEPROM
 - Built-in hardware emulation scheme to automate EEPROM record maintenance functions
 - Programmable EEPROM data set size and FlexNVM partition code facilitating EEPROM memory endurance trade-offs
 - Supports FlexRAM aligned writes of 1, 2, or 4 bytes at a time
 - Read access to FlexRAM possible while programming or erasing data in the program or data flash memory
- When configured for traditional RAM:
 - Read and write access possible to the FlexRAM while programming or erasing data in the program or data flash memory

Introduction

16.2.1.4 Other FTFE module features

- Internal high-voltage supply generator for flash memory program and erase operations
- Optional interrupt generation upon flash command completion
- Supports MCU security mechanisms which prevent unauthorized access to the flash memory contents

16.2.2 Block diagram

The block diagram of the FTFE module is shown in the following figure.

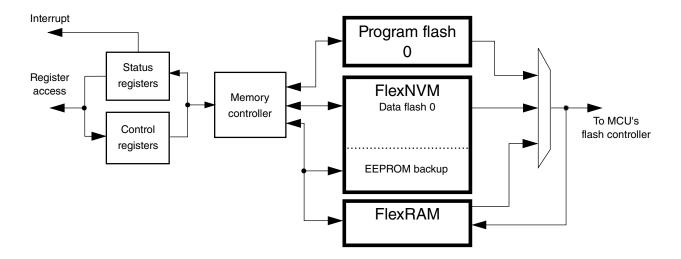


Figure 16-1. FTFE block diagram

16.2.3 Glossary

Command write sequence — A series of MCU writes to the Flash FCCOB register group that initiates and controls the execution of Flash algorithms that are built into the FTFE module.

Data flash memory — Partitioned from the FlexNVM block, the data flash memory provides nonvolatile storage for user data, boot code, and additional code store.

Data flash sector — The data flash sector is the smallest portion of the data flash memory that can be erased.

287

EEPROM — Using a built-in filing system, the FTFE module emulates the characteristics of an EEPROM by effectively providing a high-endurance, byte-writeable (program and erase) NVM.

EEPROM backup data header — The EEPROM backup data header is comprised of a 64-bit field found in EEPROM backup data memory which contains information used by the EEPROM filing system to determine the status of a specific EEPROM backup flash sector.

EEPROM backup data record — The EEPROM backup data record is comprised of a 7-bit status field, a 13-bit address field, and a 32-bit data field found in EEPROM backup data memory which is used by the EEPROM filing system. If the status field indicates a record is valid, the data field is mirrored in the FlexRAM at a location determined by the address field

EEPROM backup data memory — Partitioned from the FlexNVM block, EEPROM backup data memory provides nonvolatile storage for the EEPROM filing system representing data written to the FlexRAM requiring highest endurance.

EEPROM backup data sector — The EEPROM backup data sector contains one EEPROM header and up to 255 EEPROM backup data records, which are used by the EEPROM filing system.

Endurance — The number of times that a flash memory location can be erased and reprogrammed.

FCCOB (**Flash Common Command Object**) — A group of flash registers that are used to pass command, address, data, and any associated parameters to the memory controller in the FTFE module.

Flash block — A macro within the FTFE module which provides the nonvolatile memory storage.

FlexMemory — FTFE configuration that supports data flash, EEPROM, and FlexRAM.

FlexNVM Block — The FlexNVM block can be configured to be used as data flash memory, EEPROM backup flash memory, or a combination of both.

FlexRAM — The FlexRAM refers to a RAM, dedicated to the FTFE module, that can be configured to store EEPROM data or as traditional RAM. When configured for EEPROM, valid writes to the FlexRAM generates a new EEPROM backup data record stored in the EEPROM backup flash memory.

FTFE Module — All flash blocks plus a flash management unit providing high-level control and an interface to MCU buses.

External signal description

IFR — Nonvolatile information register found in each flash block, separate from the main memory array.

NVM — Nonvolatile memory. A memory technology that maintains stored data during power-off. The flash array is an NVM using NOR-type flash memory technology.

NVM Normal Mode — An NVM mode that provides basic user access to FTFE resources. The CPU or other bus masters initiate flash program and erase operations (or other flash commands) using writes to the FCCOB register group in the FTFE module.

Phrase — 64 bits of data with an aligned phrase having byte-address[2:0] = 000.

Longword — 32 bits of data with an aligned longword having byte-address[1:0] = 00.

Word — 16 bits of data with an aligned word having byte-address[0] = 0.

Program flash — The program flash memory provides nonvolatile storage for vectors and code store.

Program flash sector — The smallest portion of the program flash memory (consecutive addresses) that can be erased.

Retention — The length of time that data can be kept in the NVM without experiencing errors upon readout. Since erased (1) states are subject to degradation just like programmed (0) states, the data retention limit may be reached from the last erase operation (not from the programming time).

RWW— Read-While-Write. The ability to simultaneously read from one memory resource while commanded operations are active in another memory resource.

Section program buffer — Lower quarter of the FlexRAM allocated for storing large amounts of data for programming via the Program Section command.

Secure — An MCU state conveyed to the FTFE module as described in the Chip Configuration details for this device. In the secure state, reading and changing NVM contents is restricted.

16.3 External signal description

The FTFE module contains no signals that connect off-chip.

289

16.4 Memory map and registers

This section describes the memory map and registers for the FTFE module. Data read from unimplemented memory space in the FTFE module is undefined. Writes to unimplemented or reserved memory space (registers) in the FTFE module are ignored.

16.4.1 Flash configuration field description

The program flash memory contains a 16-byte flash configuration field that stores default protection settings (loaded on reset) and security information that allows the MCU to restrict access to the FTFE module.

NOTE

The flash configuration field offset addresses are relative byte addresses. Check your device specific memory map for the location of the program flash memory.

Flash Configuration Field Offset Address	Size (Bytes)	Field Description
0x0_0400 - 0x0_0407	8	Backdoor Comparison Key. Refer to Verify Backdoor Access Key command and Unsecuring the MCU Using Backdoor Key Access.
0x0_0408 - 0x0_040B	4	Program flash protection bytes. Refer to the description of the Program Flash Protection Registers (FPROT0-3).
0x0_040F	1	Data flash protection byte. Refer to the description of the Data Flash Protection Register (FDPROT).
0x0_040E	1	EEPROM protection byte. Refer to the description of the EEPROM Protection Register (FEPROT).
0x0_040D	1	Flash nonvolatile option byte. Refer to the description of the Flash Option Register (FOPT).
0x0_040C	1	Flash security byte. Refer to the description of the Flash Security Register (FSEC).

16.4.2 Program flash 0 IFR map

The program flash 0 IFR is a 1 Kbyte nonvolatile information memory that can be read freely, but the user has no erase and limited program capabilities (see the Read Once, Program Once, and Read Resource commands in Read Once Command, Program Once command and Read Resource Command). The contents of the program flash 0 IFR are summarized in the following table and further described in the subsequent paragraphs.

The program flash 0 IFR is located within the program flash 0 memory block.

Address Range	Size (Bytes)	Field Description		
0x000 – 0x39F	928	Reserved		
0x3A0 - 0x3A3	4	Program Once XACCH-1 Field (index = 0x08)		
0x3A4 - 0x3A7	4	Program Once XACCL-1 Field (index = 0x08)		
0x3A8 – 0x3AB	4	Program Once XACCH-2 Field (index = 0x09)		
0x3AC - 0x3AF	4	Program Once XACCL-2 Field (index = 0x09)		
0x3B0 - 0x3B3	4	Program Once SACCH-1 Field (index = 0x0A)		
0x3B4 - 0x3B7	4	Program Once SACCL-1 Field (index = 0x0A)		
0x3B8 - 0x3BB	4	Program Once SACCH-2 Field (index = 0x0B)		
0x3BC - 0x3BF	4	Program Once SACCL-2 Field (index = 0x0B)		
0x3C0 - 0x3FF	64	Program Once ID Field (index = 0x00 - 0x07)		

16.4.2.1 Program Once field

The Program Once field in the program flash 0 IFR provides 96 bytes of user data storage separate from the program flash 0 main array. The user can program the Program Once field one time only as there is no program flash IFR erase mechanism available to the user. The Program Once field can be read any number of times. This section of the program flash 0 IFR is accessed in 8 byte records using the Read Once and Program Once commands (see Read Once Command and Program Once command).

16.4.3 Data flash 0 IFR map

The data flash 0 IFR is a 1 Kbyte nonvolatile information memory that can be read and erased, but the user has limited program capabilities in the data flash 0 IFR (see the Program Partition command in Program Partition command, the Erase All Blocks command in Erase All Blocks Command, and the Read Resource command in Read Resource Command). The contents of the data flash 0 IFR are summarized in the following table and further described in the subsequent paragraphs.

The data flash 0 IFR is located within the data flash 0 memory block.

Address Range	Size (Bytes)	Field Description
0x00 - 0x3FB, 0x3FE - 0x3FF	1022	Reserved
0x3FD	1	EEPROM Data Set Size
0x3FC	1	FlexNVM Partition Code

16.4.3.1 EEPROM Data Set Size

The EEPROM data set size byte in the data flash 0 IFR supplies information which determines the amount of FlexRAM used in each of the available EEPROM subsystems. To program the EEERST, EEESIZE value, see the Program Partition command described in Program Partition command.

Table 16-1. EEPROM Data Set Size

	Data	a flash IFR: 0x0	3FD				
7	6	5	4	3	2	1	0
1	EEERST EEESPLIT EEESIZE						
	= Unimplemented or Reserved						

Table 16-2. EEPROM Data Set Size Field Description

Field	Description
7	This read-only bitfield is reserved and must always be written as one.
Reserved	
6	EEPROM Load on Reset — Determines whether the flash reset sequence takes time to load the
EEERST	FlexRAM with valid EEPROM data.
	'0' = FlexRAM is not loaded with valid EEPROM data during the flash reset sequence (see the Set FlexRAM Function command described in Set FlexRAM Function command to load the FlexRAM with valid EEPROM data)
	'1' = FlexRAM is loaded with valid EEPROM data during the flash reset sequence
5-4	This read-only bitfield is reserved and each bit will always read as one.
EEESPLIT	

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Table 16-2. EEPROM Data Set Size Field Description (continued)

Field	Description
3-0	EEPROM Size — Encoding of the total available FlexRAM for EEPROM use.
EEESIZE	NOTE: EEESIZE must be 0 bytes (1111b) when the FlexNVM partition code (FlexNVM partition code) is set to 'No EEPROM'.
	'0000' = Reserved
	'0001' = Reserved
	'0010' = Reserved
	'0011' = 2,048 Bytes
	'0100' = 1,024 Bytes
	'0101' = 512 Bytes
	'0110' = 256 Bytes
	'0111' = 128 Bytes
	'1000' = 64 Bytes
	'1001' = 32 Bytes
	'1010' = Reserved
	'1011' = Reserved
	'1100' = Reserved
	'1101' = Reserved
	'1110' = Reserved
	'1111' = 0 Bytes

16.4.3.2 FlexNVM partition code

The FlexNVM partition code byte in the data flash 0 IFR supplies a code which specifies how to split the FlexNVM block between data flash memory and EEPROM backup memory supporting EEPROM functions. To program the DEPART value, see the Program Partition command described in Program Partition command.

Table 16-3. FlexNVM partition code

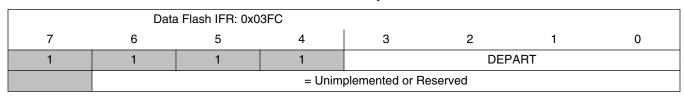


Table 16-4. FlexNVM partition code field description

Field	Description
7-4	This read-only bitfield is reserved and must always be written as one.

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Table 16-4. FlexNVM partition code field description (continued)

Field	Description		
Reserved			
3-0		- Encoding of the data flash / EEPRO	
DEPART	memory block. FlexNVM me	emory not partitioned for data flash is	used to store EEPROM recor
	DEPART	Data flash (KByte)	EEPROM backup (KB
	0000	32	0
	0001	Reserved	Reserved
	0010	Reserved	Reserved
	0011	0	32
	0100	Reserved	Reserved
	0101	Reserved	Reserved
	0110	Reserved	Reserved
	0111	Reserved	Reserved
	1000	0	32
	1001	8	24
	1010	Reserved	Reserved
	1011	32	0
	1100	Reserved	Reserved
	1101	Reserved	Reserved
	1110	Reserved	Reserved
	1111	32	0

16.4.4 Register descriptions

The FTFE module contains a set of memory-mapped control and status registers.

NOTE

While a command is running (FSTAT[CCIF]=0), register writes are not accepted to any register except FCNFG and FSTAT. The no-write rule is relaxed during the start-up reset sequence, prior to the initial rise of CCIF. During this initialization period the user may write any register. All register writes are also disabled (except for registers FCNFG and FSTAT) whenever an erase suspend request is active (FCNFG[ERSSUSP]=1).

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Memory map and registers

FTFE memory map

Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page
4002_0000	Flash Status Register (FTFE_FSTAT)	8	R/W	00h	16.4.4.1/ 295
4002_0001	Flash Configuration Register (FTFE_FCNFG)	8	R/W	00h	16.4.4.2/ 297
4002_0002	Flash Security Register (FTFE_FSEC)	8	R	Undefined	16.4.4.3/ 299
4002_0003	Flash Option Register (FTFE_FOPT)	8	R	Undefined	16.4.4.4/ 300
4002_0004	Flash Common Command Object Registers (FTFE_FCCOB3)	8	R/W	00h	16.4.4.5/ 301
4002_0005	Flash Common Command Object Registers (FTFE_FCCOB2)	8	R/W	00h	16.4.4.5/ 301
4002_0006	Flash Common Command Object Registers (FTFE_FCCOB1)	8	R/W	00h	16.4.4.5/ 301
4002_0007	Flash Common Command Object Registers (FTFE_FCCOB0)	8	R/W	00h	16.4.4.5/ 301
4002_0008	Flash Common Command Object Registers (FTFE_FCCOB7)	8	R/W	00h	16.4.4.5/ 301
4002_0009	Flash Common Command Object Registers (FTFE_FCCOB6)	8	R/W	00h	16.4.4.5/ 301
4002_000A	Flash Common Command Object Registers (FTFE_FCCOB5)	8	R/W	00h	16.4.4.5/ 301
4002_000B	Flash Common Command Object Registers (FTFE_FCCOB4)	8	R/W	00h	16.4.4.5/ 301
4002_000C	Flash Common Command Object Registers (FTFE_FCCOBB)	8	R/W	00h	16.4.4.5/ 301
4002_000D	Flash Common Command Object Registers (FTFE_FCCOBA)	8	R/W	00h	16.4.4.5/ 301
4002_000E	Flash Common Command Object Registers (FTFE_FCCOB9)	8	R/W	00h	16.4.4.5/ 301
4002_000F	Flash Common Command Object Registers (FTFE_FCCOB8)	8 R/W		00h	16.4.4.5/ 301
4002_0010	Program Flash Protection Registers (FTFE_FPROT3) 8 R/W		R/W	Undefined	16.4.4.6/ 302
4002_0011	Program Flash Protection Registers (FTFE_FPROT2)		R/W	Undefined	16.4.4.6/ 302
4002_0012	Program Flash Protection Registers (FTFE_FPROT1) 8		R/W	Undefined	16.4.4.6/ 302
4002_0013	Program Flash Protection Registers (FTFE_FPROT0)	8 R/W		Undefined	16.4.4.6/ 302
4002_0016	EEPROM Protection Register (FTFE_FEPROT)	8	R/W	Undefined	16.4.4.7/ 303
4002_0017	Data Flash Protection Register (FTFE_FDPROT)	8	R/W	Undefined	16.4.4.8/ 304

Table continues on the next page...

FTFE memory map (continued)

Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page
4002_0018	Execute-only Access Registers (FTFE_XACCH3)	8	R	Undefined	16.4.4.9/ 305
4002_0019	Execute-only Access Registers (FTFE_XACCH2)	8	R	Undefined	16.4.4.9/ 305
4002_001A	Execute-only Access Registers (FTFE_XACCH1)	8	R	Undefined	16.4.4.9/ 305
4002_001B	Execute-only Access Registers (FTFE_XACCH0)	8	R	Undefined	16.4.4.9/ 305
4002_001C	Execute-only Access Registers (FTFE_XACCL3)	8	R	Undefined	16.4.4.9/ 305
4002_001D	Execute-only Access Registers (FTFE_XACCL2)	8	R	Undefined	16.4.4.9/ 305
4002_001E	Execute-only Access Registers (FTFE_XACCL1)	8	R	Undefined	16.4.4.9/ 305
4002_001F	Execute-only Access Registers (FTFE_XACCL0)	8	R	Undefined	16.4.4.9/ 305
4002_0020	Supervisor-only Access Registers (FTFE_SACCH3)	8	R	Undefined	16.4.4.10/ 306
4002_0021	Supervisor-only Access Registers (FTFE_SACCH2)	8	R	Undefined	16.4.4.10/ 306
4002_0022	Supervisor-only Access Registers (FTFE_SACCH1)	8	R	Undefined	16.4.4.10/ 306
4002_0023	Supervisor-only Access Registers (FTFE_SACCH0)	8	R	Undefined	16.4.4.10/ 306
4002_0024	Supervisor-only Access Registers (FTFE_SACCL3)	8	R	Undefined	16.4.4.10/ 306
4002_0025	Supervisor-only Access Registers (FTFE_SACCL2)	8	R	Undefined	16.4.4.10/ 306
4002_0026	Supervisor-only Access Registers (FTFE_SACCL1)	8	R	Undefined	16.4.4.10/ 306
4002_0027	Supervisor-only Access Registers (FTFE_SACCL0)	8	R	Undefined	16.4.4.10/ 306
4002_0028	Flash Access Segment Size Register (FTFE_FACSS)	8	R	Undefined	16.4.4.11/ 308
4002_002B	Flash Access Segment Number Register (FTFE_FACSN)	8	R	Undefined	16.4.4.12/ 308

16.4.4.1 Flash Status Register (FTFE_FSTAT)

The FSTAT register reports the operational status of the FTFE module.

The CCIF, RDCOLERR, ACCERR, and FPVIOL bits are readable and writable. The MGSTAT0 bit is read only. The unassigned bits read 0 and are not writable.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

NOTE

When set, the Access Error (ACCERR) and Flash Protection Violation (FPVIOL) bits in this register prevent the launch of any more commands or writes to the FlexRAM (when EEERDY is set) until the flag is cleared (by writing a one to it).

Address: 4002_0000h base + 0h offset = 4002_0000h

Bit	7	6	5	4	3	2	1	0
Read	CCIF	RDCOLERR	ACCERR	FPVIOL		0		MGSTAT0
Write	w1c	w1c	w1c	w1c				
Reset	0	0	0	0	0	0	0	0

FTFE_FSTAT field descriptions

Field	Description
7	Command Complete Interrupt Flag
CCIF	The CCIF flag indicates that a FTFE command or EEPROM file system operation has completed. The CCIF flag is cleared by writing a 1 to CCIF to launch a command, and CCIF stays low until command completion or command violation. The CCIF flag is also cleared by a successful write to FlexRAM while enabled for EEPROM operations, and CCIF stays low until the EEPROM file system has created the associated EEPROM data record.
	The CCIF bit is reset to 0 but is set to 1 by the memory controller at the end of the reset initialization sequence. Depending on how quickly the read occurs after reset release, the user may or may not see the 0 hardware reset value.
	0 FTFE command or EEPROM file system operation in progress 1 FTFE command or EEPROM file system operation has completed
6	FTFE Read Collision Error Flag
RDCOLERR	The RDCOLERR error bit indicates that the MCU attempted a read from an FTFE resource that was being manipulated by an FTFE command (CCIF=0). Any simultaneous access is detected as a collision error by the block arbitration logic. The read data in this case cannot be guaranteed. The RDCOLERR bit is cleared by writing a 1 to it. Writing a 0 to RDCOLERR has no effect.
	0 No collision error detected
	1 Collision error detected
5	Flash Access Error Flag
ACCERR	The ACCERR error bit indicates an illegal access has occurred to an FTFE resource caused by a violation of the command write sequence or issuing an illegal FTFE command. While ACCERR is set, the CCIF flag cannot be cleared to launch a command. The ACCERR bit is cleared by writing a 1 to ACCERR while CCIF is set. Writing a 0 to the ACCERR bit has no effect.
	0 No access error detected
	1 Access error detected
4 FPVIOL	Flash Protection Violation Flag The FPVIOL error bit indicates an attempt was made to program or erase an address in a protected area of program flash or data flash memory during a command write sequence or a write was attempted to a protected area of the FlexRAM while enabled for EEPROM. While FPVIOL is set, the CCIF flag cannot be cleared to launch a command. The FPVIOL bit is cleared by writing a 1 to FPVIOL while CCIF is set. Writing a 0 to the FPVIOL bit has no effect.

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

FTFE_FSTAT field descriptions (continued)

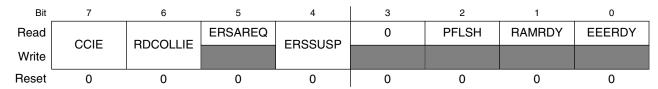
Field	Description					
	0 No protection violation detected					
	1 Protection violation detected					
3–1	This field is reserved.					
Reserved	This read-only field is reserved and always has the value 0.					
0	Memory Controller Command Completion Status Flag					
MGSTAT0	The MGSTAT0 status flag is set if an error is detected during execution of an FTFE command or during the flash reset sequence. As a status flag, this bit cannot (and need not) be cleared by the user like the other error flags in this register.					
	The value of the MGSTAT0 bit for "command-N" is valid only at the end of the "command-N" execution when CCIF=1 and before the next command has been launched. At some point during the execution of "command-N+1," the previous result is discarded and any previous error is cleared.					

16.4.4.2 Flash Configuration Register (FTFE_FCNFG)

This register provides information on the current functional state of the FTFE module.

The erase control bits (ERSAREQ and ERSSUSP) have write restrictions. PFLSH, RAMRDY, and EEERDY are read-only status bits. The reset values for the PFLSH, RAMRDY, and EEERDY bits are determined during the reset sequence.

Address: 4002_0000h base + 1h offset = 4002_0001h



FTFE_FCNFG field descriptions

Field	Description
7	Command Complete Interrupt Enable
CCIE	The CCIE bit controls interrupt generation when an FTFE command completes.
	0 Command complete interrupt disabled
	Command complete interrupt enabled. An interrupt request is generated whenever the FSTAT[CCIF] flag is set.
6	Read Collision Error Interrupt Enable
RDCOLLIE	The RDCOLLIE bit controls interrupt generation when an FTFE read collision error occurs.
	0 Read collision error interrupt disabled
	1 Read collision error interrupt enabled. An interrupt request is generated whenever an FTFE read collision error is detected (see the description of FSTAT[RDCOLERR]).
5	Erase All Request
ERSAREQ	

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Memory map and registers

FTFE_FCNFG field descriptions (continued)

Field	Description						
	This bit issues a request to the memory controller to execute the Erase All Blocks command and release security. ERSAREQ is not directly writable but is under indirect user control. Refer to the device's Chip Configuration details on how to request this command.						
	The ERSAREQ bit sets when an erase all request is triggered external to the FTFE and CCIF is set (no command is currently being executed). ERSAREQ is cleared by the FTFE when the operation completes.						
	0 No request or request complete 1 Request to: 1. run the Erase All Blocks command, 2. verify the erased state, 3. program the security byte in the Flash Configuration Field to the unsecure state, and 4. release MCU security by setting the FSEC[SEC] field to the unsecure state						
4 ERSSUSP	Erase Suspend						
ERSSUSP	The ERSSUSP bit allows the user to suspend (interrupt) the Erase Flash Sector command while it is executing.						
	No suspend requestedSuspend the current Erase Flash Sector command execution						
3	This field is reserved.						
Reserved	This read-only field is reserved and always has the value 0.						
2 PFLSH	FTFE configuration 0 FTFE configuration supports one program flash block and one FlexNVM block						
	1 Reserved						
1 RAMRDY	RAM Ready This flag indicates the current status of the FlexRAM.						
	The state of the RAMRDY flag is normally controlled by the Set FlexRAM Function command. During the reset sequence, the RAMRDY flag is cleared if the FlexNVM block is partitioned for EEPROM and will be set if the FlexNVM block is not partitioned for EEPROM . The RAMRDY flag is cleared if the Program Partition command is run to partition the FlexNVM block for EEPROM. The RAMRDY flag sets after completion of the Erase All Blocks command or execution of the erase-all operation triggered external to the FTFE.						
	0 FlexRAM is not available for traditional RAM access						
	FlexRAM is available as traditional RAM only; writes to the FlexRAM do not trigger EEPROM operations						
0 EEERDY	This flag indicates if the EEPROM backup data has been copied to the FlexRAM and is therefore available for read access.						
	During the reset sequence, the EEERDY flag remains clear while CCIF=0 and only sets if the FlexNVM block is partitioned for EEPROM.						
	0 FlexRAM is not available for EEPROM operation						
	FlexRAM is available for EEPROM operations where: reads from the FlexRAM return data previously written to the FlexRAM in EEPROM mode and writes launch an EEPROM operation to store the written data in the FlexRAM and EEPROM backup						

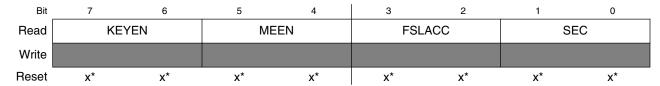
Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

16.4.4.3 Flash Security Register (FTFE_FSEC)

This read-only register holds all bits associated with the security of the MCU and FTFE module.

During the reset sequence, the register is loaded with the contents of the flash security byte in the Flash Configuration Field located in program flash memory. The Flash basis for the values is signified by X in the reset value.

Address: 4002_0000h base + 2h offset = 4002_0002h



^{*} Notes:

FTFE_FSEC field descriptions

Field	Description					
7–6	Backdoor Key Security Enable					
KEYEN	These bits enable and disable backdoor key access to the FTFE module.					
	00 Backdoor key access disabled					
	01 Backdoor key access disabled (preferred KEYEN state to disable backdoor key access)					
	10 Backdoor key access enabled					
	11 Backdoor key access disabled					
5–4	Mass Erase Enable Bits					
MEEN	Enables and disables mass erase capability of the FTFE module. When the SEC field is set to unsecure, the MEEN setting does not matter.					
	00 Mass erase is enabled					
	01 Mass erase is enabled					
	10 Mass erase is disabled					
	11 Mass erase is enabled					
3–2	Factory Security Level Access Code					
FSLACC	These bits enable or disable access to the flash memory contents during returned part failure analysis at NXP. When SEC is secure and FSLACC is denied, access to the program flash contents is denied and any failure analysis performed by NXP factory test must begin with a full erase to unsecure the part.					
	When access is granted (SEC is unsecure, or SEC is secure and FSLACC is granted), NXP factory testing has visibility of the current flash contents. The state of the FSLACC bits is only relevant when the SEC bits are set to secure. When the SEC field is set to unsecure, the FSLACC setting does not matter.					
	00 Factory access granted					
	01 Factory access denied					

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

[•] x = Undefined at reset.

FTFE_FSEC field descriptions (continued)

Field	Description					
	10 Factory access denied					
	11 Factory access granted					
SEC	Flash Security					
	These bits define the security state of the MCU. In the secure state, the MCU limits access to FTFE module resources. The limitations are defined per device and are detailed in the Chip Configuration details. If the FTFE module is unsecured using backdoor key access, the SEC bits are forced to 10b.					
	00 MCU security status is secure					
	01 MCU security status is secure					
	10 MCU security status is unsecure (The standard shipping condition of the FTFE is unsecure.)					
	11 MCU security status is secure					

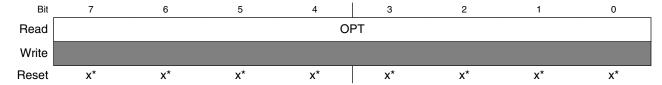
Flash Option Register (FTFE_FOPT) 16.4.4.4

The flash option register allows the MCU to customize its operations by examining the state of these read-only bits, which are loaded from NVM at reset. The function of the bits is defined in the device's Chip Configuration details.

All bits in the register are read-only.

During the reset sequence, the register is loaded from the flash nonvolatile option byte in the Flash Configuration Field located in program flash memory. The flash basis for the values is signified by X in the reset value.

Address: 4002_0000h base + 3h offset = 4002_0003h



^{*} Notes:

FTFE_FOPT field descriptions

Field	Description
OPT	Nonvolatile Option These bits are leaded from flesh to this register at reset. Refer to the device's Chip Configuration details.
	These bits are loaded from flash to this register at reset. Refer to the device's Chip Configuration details for the definition and use of these bits.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

x = Undefined at reset.

16.4.4.5 Flash Common Command Object Registers (FTFE_FCCOBn)

The FCCOB register group provides 12 bytes for command codes and parameters. The individual bytes within the set append a 0-B hex identifier to the FCCOB register name: FCCOB0, FCCOB1, ..., FCCOBB.

Address: 4002_0000h base + 4h offset + $(1d \times i)$, where i=0d to 11d

Bit	7	6	5	4	3	2	1	0
Read Write				CCC	OBn			
Reset	0	0	0	0	0	0	0	0

FTFE_FCCOBn field descriptions

Field	Description					
CCOBn	The FCCOB register provides a command code and relevant parameters to the memory controller. The individual registers that compose the FCCOB data set can be written in any order, but you must provide all needed values, which vary from command to command. First, set up all required FCCOB fields and then initiate the command's execution by writing a 1 to the FSTAT[CCIF] bit. This clears the CCIF bit, which locks all FCCOB parameter fields and they cannot be changed by the user until the command completes (CCIF returns to 1). No command buffering or queueing is provided; the next command can be loaded only after the current command completes.					
		nformation to the FCCOB registers. Any values returned to FCCOB are available T[CCIF] flag returns to 1 by the memory controller.				
	The following table shows a generic FTFE command format. The first FCCOB register, FCCOB0, always contains the command code. This 8-bit value defines the command to be executed. The command code is followed by the parameters required for this specific FTFE command, typically an address and/or data values.					
	NOTE: The command parameter table is written in terms of FCCOB Number (which is equivalent to the byte number). This number is a reference to the FCCOB register name and is not the register address.					
	FCCOB Number ¹	Typical Command Parameter Contents [7:0]				
	0	FCMD (a code that defines the FTFE command)				
	1	Flash address [23:16]				
	2	Flash address [15:8]				
	3	Flash address [7:0]				
	4	Data Byte 0				
	5	Data Byte 1				
	6	Data Byte 2				
	7	Data Byte 3				
	8	Data Byte 4				
	9	Data Byte 5				
	Α	Data Byte 6				
	В	Data Byte 7				

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

FTFE_FCCOBn field descriptions (continued)

Field	Description				
	FCCOB Endianness and Multi-Byte Access:				
	The FCCOB register group uses a big endian addressing convention. For all command parameter fields larger than 1 byte, the most significant data resides in the lowest FCCOB register number. The FCCOB register group may be read and written as individual bytes, aligned words (2 bytes) or aligned longwords (4 bytes).				

^{1.} Refers to FCCOB register name, not register address

16.4.4.6 Program Flash Protection Registers (FTFE_FPROT*n*)

The FPROT registers define which program flash regions are protected from program and erase operations. Protected flash regions cannot have their content changed; that is, these regions cannot be programmed and cannot be erased by any FTFE command. Unprotected regions can be changed by program and erase operations.

The four FPROT registers allow up to 32 protectable regions of equal memory size.

Program flash protection register	Program flash protection bits
FPROT0	PROT[31:24]
FPROT1	PROT[23:16]
FPROT2	PROT[15:8]
FPROT3	PROT[7:0]

During the reset sequence, the FPROT registers are loaded with the contents of the program flash protection bytes in the Flash Configuration Field as indicated in the following table.

Program flash protection register	Flash Configuration Field offset address
FPROT0	0x000B
FPROT1	0x000A
FPROT2	0x0009
FPROT3	0x0008

To change the program flash protection that is loaded during the reset sequence, unprotect the sector of program flash memory that contains the Flash Configuration Field. Then, reprogram the program flash protection byte.

Address: 4002_0000h base + 10h offset + (1d × i), where i=0d to 3d

Bit	7	6	5	4	3	2	1	0
Read Write	PROT							
Reset	x *	x *	x *	x *	x*	x *	x *	X*

^{*} Notes:

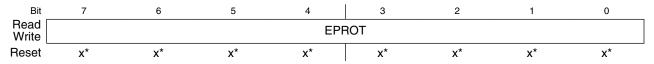
FTFE_FPROTn field descriptions

Field	Description
PROT	Program Flash Region Protect
	Each program flash region can be protected from program and erase operations by setting the associated PROT bit to the protected state.
	The protection can only be increased, meaning that currently unprotected memory can be protected, but currently protected memory cannot be unprotected. Since unprotected regions are marked with a 1 and protected regions use a 0, only writes changing 1s to 0s are accepted. This 1-to-0 transition check is performed on a bit-by-bit basis. Those FPROT bits with 1-to-0 transitions are accepted while all bits with 0-to-1 transitions are ignored.
	Restriction: The user must never write to any FPROT register while a command is running (CCIF=0).
	Trying to alter data in any protected area in the program flash memory results in a protection violation error and sets the FSTAT[FPVIOL] bit. A full block erase of a program flash block is not possible if it contains any protected region.
	0 Program flash region is protected.
	1 Program flash region is not protected

16.4.4.7 EEPROM Protection Register (FTFE_FEPROT)

The FEPROT register defines which EEPROM regions of the FlexRAM are protected against program and erase operations. Protected EEPROM regions cannot have their content changed by writing to it. Unprotected regions can be changed by writing to the FlexRAM.

Address: 4002_0000h base + 16h offset = 4002_0016h



^{*} Notes:

[•] x = Undefined at reset.

[•] x = Undefined at reset.

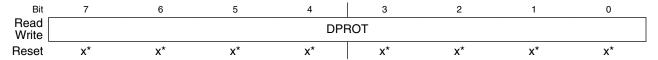
FTFE_FEPROT field descriptions

Field	Description	
EPROT	EEPROM Region Protect	
	Individual EEPROM regions can be protected from alteration by setting the associated EPROT bit to the protected state. The EPROT bits are not used when the FlexNVM Partition Code is set to data flash only. When the FlexNVM Partition Code is set to data flash and EEPROM or EEPROM only, each EPROT bit covers one-eighth of the configured EEPROM data (see the EEPROM Data Set Size parameter description).	
	The protection can only be increased. This means that currently-unprotected memory can be protected, but currently-protected memory cannot be unprotected. Since unprotected regions are marked with a 1 and protected regions use a 0, only writes changing 1s to 0s are accepted. This 1-to-0 transition check is performed on a bit-by-bit basis. Those FEPROT bits with 1-to-0 transitions are accepted while all bits with 0-to-1 transitions are ignored.	
	Restriction: Never write to the FEPROT register while a command is running (CCIF=0).	
	Reset: During the reset sequence, the FEPROT register is loaded with the contents of the EEPROM protection byte in the Flash Configuration Field located in program flash. The flash basis for the reset values is signified by X in the register diagram. To change the EEPROM protection that will be loaded during the reset sequence, the sector of program flash that contains the Flash Configuration Field must be unprotected; then the EEPROM protection byte must be erased and reprogrammed.	
	Trying to alter data by writing to any protected area in the EEPROM results in a protection violation error and sets the FSTAT[FPVIOL] bit.	
	0 EEPROM region is protected 1 EEPROM region is not protected	
	ELI HOM region le not protected	

16.4.4.8 Data Flash Protection Register (FTFE_FDPROT)

The FDPROT register defines which data flash regions are protected against program and erase operations. Protected Flash regions cannot have their content changed; that is, these regions cannot be programmed and cannot be erased by any FTFE command. Unprotected regions can be changed by both program and erase operations.

Address: 4002_0000h base + 17h offset = 4002_0017h



^{*} Notes:

• x = Undefined at reset.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018 304 **NXP Semiconductors**

305

FTFE_FDPROT field descriptions

Field	Description
DPROT	Data Flash Region Protect
	Individual data flash regions can be protected from program and erase operations by setting the associated DPROT bit to the protected state. Each DPROT bit protects one-eighth of the partitioned data flash memory space. The granularity of data flash protection cannot be less than the data flash sector size. If an unused DPROT bit is set to the protected state, the Erase all Blocks command does not execute and sets the FSTAT[FPVIOL] bit.
	The protection can only be increased, meaning that currently unprotected memory can be protected but currently protected memory cannot be unprotected. Since unprotected regions are marked with a 1 and protected regions use a 0, only writes changing 1s to 0s are accepted. This 1-to-0 transition check is performed on a bit-by-bit basis. Those FDPROT bits with 1-to-0 transitions are accepted while all bits with 0-to-1 transitions are ignored.
	Restriction: The user must never write to the FDPROT register while a command is running (CCIF=0).
	Reset: During the reset sequence, the FDPROT register is loaded with the contents of the data flash protection byte in the Flash Configuration Field located in program flash memory. The flash basis for the reset values is signified by X in the register diagram. To change the data flash protection that will be loaded during the reset sequence, unprotect the sector of program flash that contains the Flash Configuration Field. Then, erase and reprogram the data flash protection byte.
	Trying to alter data with the program and erase commands in any protected area in the data flash memory results in a protection violation error and sets the FSTAT[FPVIOL] bit. A block erase of any data flash memory block (see the Erase Flash Block command description) is not possible if the data flash block contains any protected region or if the FlexNVM memory has been partitioned for EEPROM.
	0 Data Flash region is protected
	1 Data Flash region is not protected

16.4.4.9 Execute-only Access Registers (FTFE_XACCn)

The XACC registers define which program flash segments are restricted to data read or execute only or both data and instruction fetches.

The eight XACC registers allow up to 64 restricted segments of equal memory size.

Execute-only access register	Program flash execute-only access bits
XACCH0	XA[63:56]
XACCH1	XA[55:48]
XACCH2	XA[47:40]
XACCH3	XA[39:32]
XACCL0	XA[31:24]
XACCL1	XA[23:16]
XACCL2	XA[15:8]
XACCL3	XA[7:0]

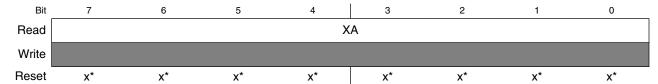
Memory map and registers

During the reset sequence, the XACC registers are loaded with the logical AND of Program Flash IFR addresses A and B as indicated in the following table.

Execute-only access register	Program Flash IFR address A	Program Flash IFR address B
XACCH0	0x03A3	0x03AB
XACCH1	0x03A2	0x03AA
XACCH2	0x03A1	0x03A9
XACCH3	0x03A0	0x03A8
XACCL0	0x03A7	0x03AF
XACCL1	0x03A6	0x03AE
XACCL2	0x03A5	0x03AD
XACCL3	0x03A4	0x03AC

Use the Program Once command to program the execute-only access control fields that are loaded during the reset sequence.

Address: 4002_0000h base + 18h offset + (1d × i), where i=0d to 7d



^{*} Notes:

FTFE_XACCn field descriptions

Field	Description
XA	Execute-only access control
	 Associated segment is accessible in execute mode only (as an instruction fetch) Associated segment is accessible as data or in execute mode

16.4.4.10 Supervisor-only Access Registers (FTFE_SACCn)

The SACC registers define which program flash segments are restricted to supervisor only or user and supervisor access.

The eight SACC registers allow up to 64 restricted segments of equal memory size.

Supervisor-only access register	Program flash supervisor-only access bits
SACCH0	SA[63:56]
SACCH1	SA[55:48]

Table continues on the next page...

[•] x = Undefined at reset.

Supervisor-only access register	Program flash supervisor-only access bits
SACCH2	SA[47:40]
SACCH3	SA[39:32]
SACCL0	SA[31:24]
SACCL1	SA[23:16]
SACCL2	SA[15:8]
SACCL3	SA[7:0]

During the reset sequence, the SACC registers are loaded with the logical AND of Program Flash IFR addresses A and B as indicated in the following table.

Supervisor-only access register	Program Flash IFR address A	Program Flash IFR address B
SACCH0	0x03B3	0x03BB
SACCH1	0x03B2	0x03BA
SACCH2	0x03B1	0x03B9
SACCH3	0x03B0	0x03B8
SACCL0	0x03B7	0x03BF
SACCL1	0x03B6	0x03BE
SACCL2	0x03B5	0x03BD
SACCL3	0x03B4	0x03BC

Use the Program Once command to program the supervisor-only access control fields that are loaded during the reset sequence.

Address: 4002_0000h base + 20h offset + (1d × i), where i=0d to 7d



- * Notes:
- x = Undefined at reset.

FTFE_SACCn field descriptions

Field	Description	
SA	Supervisor-only access control	
	Associated segment is accessible in supervisor mode only Associated segment is accessible in user or supervisor mode	

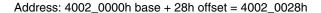
Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

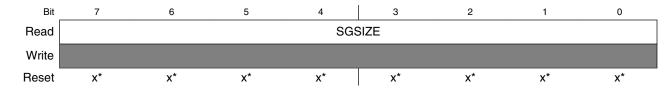
16.4.4.11 Flash Access Segment Size Register (FTFE_FACSS)

The flash access segment size register determines which bits in the address are used to index into the SACC and XACC bitmaps to get the appropriate permission flags.

All bits in the register are read-only.

The contents of this register are loaded during the reset sequence.





^{*} Notes:

FTFE_FACSS field descriptions

Field	Description			
SGSIZE	Segment Size			
	The segment size is a fixed value based on the available program flash size divided by NUMSG.			
	Program Flash Size	Segment Size	Segment Size Encoding	
	256 KBytes	4 KBytes	0x4	
	512 KBytes	8 KBytes	0x5	
	768 KBytes	16 KBytes	0x6	
	1 MByte	16 KBytes	0x6	
	1.5 MBytes	32 KBytes	0x7	
	2 MBytes	32 KBytes	0x7	

16.4.4.12 Flash Access Segment Number Register (FTFE_FACSN)

The flash access segment number register provides the number of program flash segments that are available for XACC and SACC permissions.

All bits in the register are read-only.

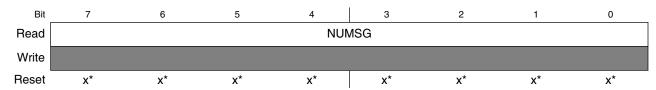
The contents of this register are loaded during the reset sequence.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

NXP Semiconductors

[•] x = Undefined at reset.

Address: 4002_0000h base + 2Bh offset = 4002_002Bh



^{*} Notes:

FTFE_FACSN field descriptions

Field	Description
NUMSG	Number of Segments Indicator
	The NUMSG field indicates the number of equal-sized segments in the program flash.
	0x30 Program flash memory is divided into 48 segments (768 Kbytes, 1.5 Mbytes)
	0x40 Program flash memory is divided into 64 segments (256 Kbytes, 512 Kbytes, 1 Mbyte, 2 Mbytes)

16.5 Functional Description

The following sections describe functional details of the FTFE module.

16.5.1 Flash Protection

Individual regions within the flash memory can be protected from program and erase operations. Protection is controlled by the following registers:

• FPROT*n* — Four registers protect 32 regions of the program flash memory as shown in the following figure

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

[•] x = Undefined at reset.

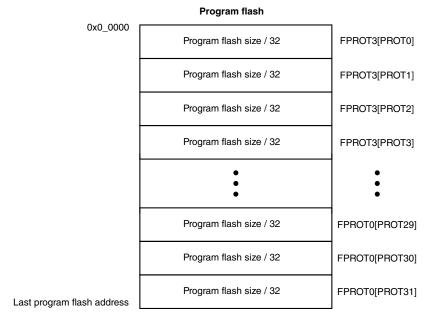


Figure 16-2. Program flash protection

- FDPROT
 - For 2ⁿ data flash sizes, protects eight regions of the data flash memory as shown in the following figure

FlexNVM

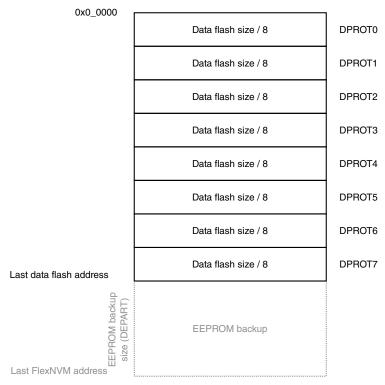


Figure 16-3. Data flash protection (2ⁿ data flash sizes)

• FEPROT — Protects eight regions of the EEPROM memory as shown in the following figure

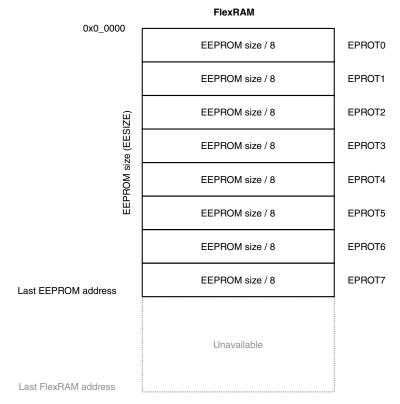


Figure 16-4. EEPROM protection

NOTE

Flash protection features are discussed further in AN4507: Using the Kinetis Security and Flash Protection Features. Some features described in the application note may not be available on this device.

16.5.2 Flash Access Protection

Individual segments within the program flash memory can be designated for restricted access. Specific flash commands (Program Check, Program Phrase, Erase Flash Block, Erase Flash Sector) monitor FXACC contents to protect flash memory but the FSACC contents do not impact flash command operation.

See AN5112: Using the Kinetis Flash Execute-Only Access Control Feature for further details.

Access is controlled by the following registers:

- FXACC
 - eight registers control 64 segments of the program flash memory as shown in the following figure

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

	i rogram nasn	
0x0_0000	Program flash size / 64	XACCL3[XA0]
	Program flash size / 64	XACCL3[XA1]
	Program flash size / 64	XACCL3[XA2]
	Program flash size / 64	XACCL3[XA3]
	Program flash size / 64	XACCL3[XA4]
	:	:
	Program flash size / 64	XACCL0[XA31]
	Program flash size / 64	XACCH3[XA32]
	:	:
	Program flash size / 64	XACCH0[XA29]
	Program flash size / 64	XACCH0[XA60]
	Program flash size / 64	XACCH0[XA61]
	Program flash size / 64	XACCH0[XA62]
Last program flash address	Program flash size / 64	XACCH0[XA63]

Program flash

Figure 16-5. Program flash execute-only access control

- FSACC
 - eight registers control 64 segments of the program flash memory as shown in the following figure

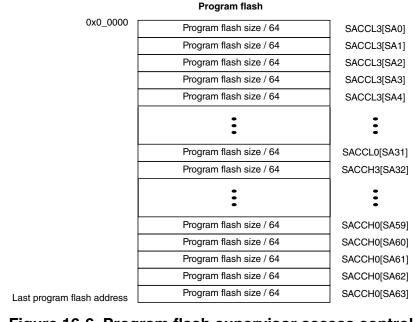


Figure 16-6. Program flash supervisor access control

16.5.3 FlexNVM Description

This section describes the FlexNVM memory.

313

16.5.3.1 FlexNVM Block Partitioning for FlexRAM

The user can configure the FlexNVM block as either:

- Basic data flash,
- EEPROM flash records to support the built-in EEPROM feature, or
- A combination of both.

The user's FlexNVM configuration choice is specified using the Program Partition command described in Program Partition command.

CAUTION

While different partitions of the FlexNVM block are available, the intention is that a single partition choice is used throughout the entire lifetime of a given application. The FlexNVM partition code choices affect the endurance and data retention characteristics of the device.

16.5.3.2 EEPROM User Perspective

The EEPROM system is shown in the following figure.

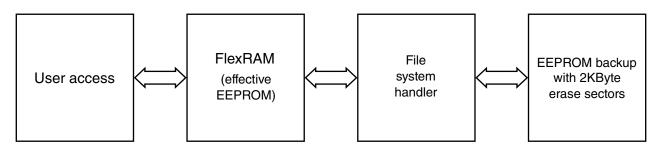


Figure 16-7. Top Level EEPROM Architecture

To handle varying customer requirements, the FlexRAM and FlexNVM blocks can be split into partitions as shown in the figure below.

1. **EEPROM partition** (EEESIZE) — The amount of FlexRAM used for EEPROM can be set from 0 Bytes (no EEPROM) to the maximum FlexRAM size (see Table 16-2). The remainder of the FlexRAM not used for EEPROM is not accessible while the FlexRAM is configured for EEPROM (see Set FlexRAM Function command). The EEPROM partition grows upward from the bottom of the FlexRAM address space.

Functional Description

- 2. **Data flash partition** (DEPART) The amount of FlexNVM memory used for data flash can be programmed from 0 bytes (all of the FlexNVM block is available for EEPROM backup) to the maximum size of the FlexNVM block (see Table 16-4).
- 3. **FlexNVM EEPROM partition** The amount of FlexNVM memory used for EEPROM backup, which is equal to the FlexNVM block size minus the data flash memory partition size. The EEPROM backup size must be at least 16 times the EEPROM partition size in FlexRAM.

The partition information (EEESIZE, DEPART) is stored in the data flash IFR and is programmed using the Program Partition command (see Program Partition command). Typically, the Program Partition command is executed only once in the lifetime of the device.

Data flash memory is useful for applications that need to quickly store large amounts of data or store data that is static. The EEPROM partition in FlexRAM is useful for storing smaller amounts of data that will be changed often.

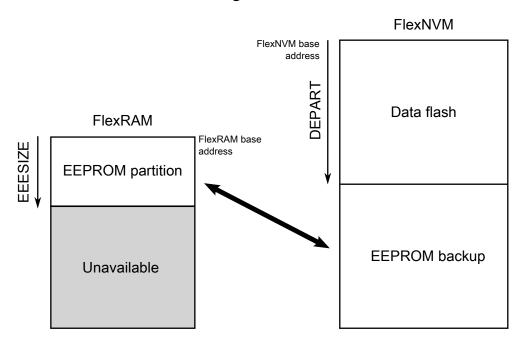


Figure 16-8. FlexRAM to FlexNVM Memory Mapping for EEPROM

16.5.3.3 **EEPROM** implementation overview

Out of reset with the FSTAT[CCIF] bit clear, the partition settings (EEESIZE, DEPART) are read from the data flash IFR and the EEPROM file system is initialized accordingly. The EEPROM file system locates all valid EEPROM data records in EEPROM backup and copies the newest data to FlexRAM. The FSTAT[CCIF] and FCNFG[EEERDY] bits are set after data from all valid EEPROM data records is copied to the FlexRAM. After the CCIF bit is set, the FlexRAM is available for read or write access.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

When configured for EEPROM use, writes to an unprotected location in FlexRAM invokes the EEPROM file system to program a new EEPROM data record in the EEPROM backup memory in a round-robin fashion. As needed, the EEPROM file system identifies the EEPROM backup sector that is being erased for future use and partially erases that EEPROM backup sector. After a write to the FlexRAM, the FlexRAM is not accessible until the FSTAT[CCIF] bit is set. The FCNFG[EEERDY] bit will also be set. If enabled, the interrupt associated with the FSTAT[CCIF] bit can be used to determine when the FlexRAM is available for read or write access.

When configured for EEPROM use, attempts to write to the FlexRAM are ignored in VLP mode.

After a sector in EEPROM backup is full of EEPROM data records, EEPROM data records from the sector holding the oldest data are gradually copied over to a previouslyerased EEPROM backup sector. When the sector copy completes, the EEPROM backup sector holding the oldest data is tagged for erase.

16.5.3.4 Write endurance to FlexRAM for EEPROM

When the FlexNVM partition code is not set to full data flash, the EEPROM data set size can be set to any of several non-zero values.

The bytes not assigned to data flash via the FlexNVM partition code are used by the FTFE to obtain an effective endurance increase for the EEPROM data. The built-in EEPROM record management system raises the number of program/erase cycles that can be attained prior to device wear-out by cycling the EEPROM data through a larger EEPROM NVM storage space.

While different partitions of the FlexNVM are available, the intention is that a single choice for the FlexNVM partition code and EEPROM data set size is used throughout the entire lifetime of a given application. The EEPROM endurance equation and graph shown below assume that only one configuration is ever used.

Writes_FlexRAM =
$$\frac{\text{EEPROM} - 2 \times \text{EEESIZE}}{\text{EEESIZE}} \times \text{Write_efficiency} \times n_{\text{nvmcycee}}$$

where

- Writes_FlexRAM minimum number of writes to each FlexRAM location
- EEPROM allocated FlexNVM based on DEPART; entered with the Program Partition command
- EEESIZE allocated FlexRAM based on DEPART; entered with the Program Partition command

• Write_efficiency —

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018 **NXP Semiconductors** 315

Functional Description

- 0.25 for 8-bit writes to FlexRAM
- 0.50 for 16-bit or 32-bit writes to FlexRAM
- \bullet $n_{nvmcycee}$ EEPROM-backup cycling endurance

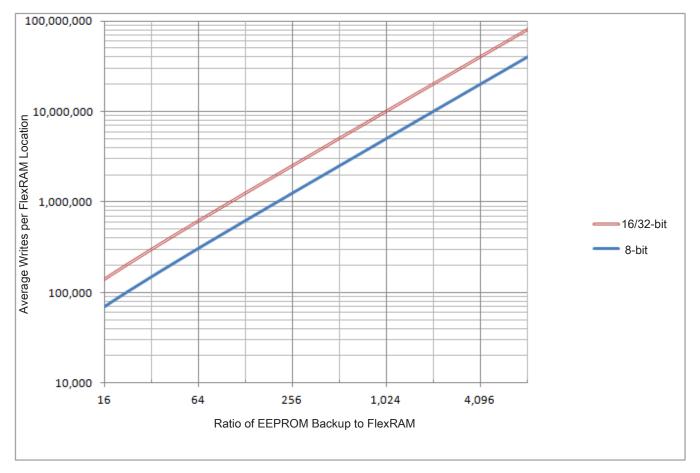


Figure 16-9. EEPROM backup writes to FlexRAM

16.5.4 Interrupts

The FTFE module can generate interrupt requests to the MCU upon the occurrence of various FTFE events. These interrupt events and their associated status and control bits are shown in the following table.

Table 16-5. FTFE Interrupt Sources

FTFE Event	Readable	Interrupt	
	Status Bit	Enable Bit	
FTFE Command Complete	FSTAT[CCIF]	FCNFG[CCIE]	
FTFE Read Collision Error	FSTAT[RDCOLERR]	FCNFG[RDCOLLIE]	

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Note

Vector addresses and their relative interrupt priority are determined at the MCU level.

16.5.5 Flash Operation in Low-Power Modes

16.5.5.1 Wait Mode

When the MCU enters wait mode, the FTFE module is not affected. The FTFE module can recover the MCU from wait via the command complete interrupt (see Interrupts).

16.5.5.2 Stop Mode

When the MCU requests stop mode, if an FTFE command is active (CCIF = 0) the command execution completes before the MCU is allowed to enter stop mode.

CAUTION

The MCU should never enter stop mode while any FTFE command is running (CCIF = 0).

NOTE

While the MCU is in very-low-power modes (VLPR, VLPW, VLPS), the FTFE module does not accept flash commands.

16.5.6 Flash memory reads and ignored writes

The FTFE module requires only the flash address to execute a flash memory read. MCU read access is available to all flash memory.

The MCU must not read from the flash memory while commands are running (as evidenced by CCIF=0) on that block. Read data cannot be guaranteed from a flash block while any command is processing within that block. The block arbitration logic detects any simultaneous access and reports this as a read collision error (see the FSTAT[RDCOLERR] bit).

16.5.7 Read while write (RWW)

The following simultaneous accesses are allowed:

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Functional Description

- The user may read from the program flash memory while commands (typically program and erase operations) are active in the data flash and FlexRAM memory space.
- The MCU can fetch instructions from program flash during both data flash program and erase operations and while EEPROM-backup is maintained by the EEPROM commands.
- Conversely, the user may read from data flash and FlexRAM while program and erase commands are executing on the program flash.
- When configured as traditional RAM, writes to the FlexRAM are allowed during data flash operations.

Simultaneous data flash operations and FlexRAM writes, when FlexRAM is used as EEPROM, are not possible.

Simultaneous operations are further discussed in Allowed simultaneous flash operations.

16.5.8 Flash Program and Erase

All flash functions except read require the user to setup and launch an FTFE command through a series of peripheral bus writes. The user cannot initiate any further FTFE commands until notified that the current command has completed. The FTFE command structure and operation are detailed in FTFE Command Operations.

FTFE Command Operations 16.5.9

FTFE command operations are typically used to modify flash memory contents. The next sections describe:

- The command write sequence used to set FTFE command parameters and launch execution
- A description of all FTFE commands available

16.5.9.1 **Command Write Sequence**

FTFE commands are specified using a command write sequence illustrated in Figure 16-10. The FTFE module performs various checks on the command (FCCOB) content and continues with command execution if all requirements are fulfilled.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018 318 NXP Semiconductors

319

Before launching a command, the ACCERR and FPVIOL bits in the FSTAT register must be zero and the CCIF flag must read 1 to verify that any previous command has completed. If CCIF is zero, the previous command execution is still active, a new command write sequence cannot be started, and all writes to the FCCOB registers are ignored.

Attempts to launch an FTFE command in VLP mode will be ignored.

16.5.9.1.1 Load the FCCOB Registers

The user must load the FCCOB registers with all parameters required by the desired FTFE command. The individual registers that make up the FCCOB data set can be written in any order.

16.5.9.1.2 Launch the Command by Clearing CCIF

Once all relevant command parameters have been loaded, the user launches the command by clearing the FSTAT[CCIF] bit by writing a '1' to it. The CCIF flag remains zero until the FTFE command completes.

The FSTAT register contains a blocking mechanism, which prevents a new command from launching (can't clear CCIF) if the previous command resulted in an access error (FSTAT[ACCERR]=1) or a protection violation (FSTAT[FPVIOL]=1). In error scenarios, two writes to FSTAT are required to initiate the next command: the first write clears the error flags, the second write clears CCIF.

16.5.9.1.3 Command Execution and Error Reporting

The command processing has several steps:

1. The FTFE reads the command code and performs a series of parameter checks and protection checks, if applicable, which are unique to each command.

If the parameter check fails, the FSTAT[ACCERR] (access error) flag is set. ACCERR reports invalid instruction codes and out-of bounds addresses. Usually, access errors suggest that the command was not set-up with valid parameters in the FCCOB register group.

Program and erase commands also check the address to determine if the operation is requested to execute on protected areas. If the protection check fails, the FSTAT[FPVIOL] (protection error) flag is set.

Functional Description

Command processing never proceeds to execution when the parameter or protection step fails. Instead, command processing is terminated after setting the FSTAT[CCIF] bit.

- 2. If the parameter and protection checks pass, the command proceeds to execution. Run-time errors, such as failure to erase verify, may occur during the execution phase. Run-time errors are reported in the FSTAT[MGSTAT0] bit. A command may have access errors, protection errors, and run-time errors, but the run-time errors are not seen until all access and protection errors have been corrected.
- 3. Command execution results, if applicable, are reported back to the user via the FCCOB and FSTAT registers.
- 4. The FTFE sets the FSTAT[CCIF] bit signifying that the command has completed.

The flow for a generic command write sequence is illustrated in the following figure.

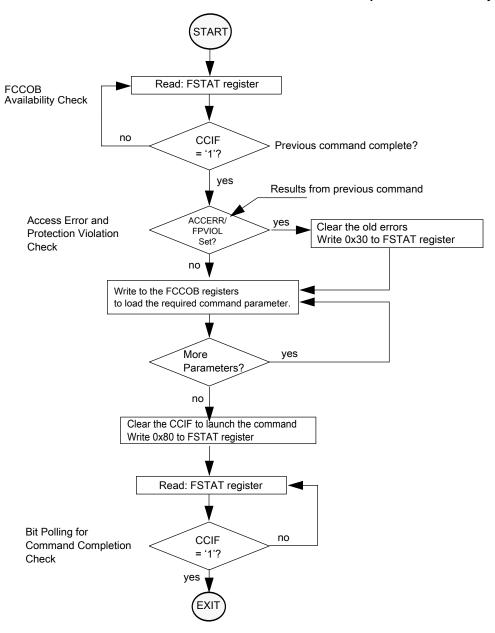


Figure 16-10. Generic Flash Command Write Sequence Flowchart

16.5.9.2 Flash commands

The following table summarizes the function of all flash commands. If any column is marked with an 'X', the flash command is relevant to that particular memory resource.

FCMD	Command	Program flash 0	Data flash	FlexRAM	Function
0x00	Read 1s Block	×	×		Verify that a program flash or data flash block is erased. FlexNVM

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Functional Description

FCMD	Command	Program flash 0	Data flash	FlexRAM	Function
					block must not be partitioned for EEPROM.
0x01	Read 1s Section	×	×		Verify that a given number of program flash or data flash locations from a starting address are erased.
0x02	Program Check	×	×		Tests previously- programmed phrases at margin read levels.
0x03	Read Resource	IFR,ID	IFR		Read 8 bytes from program flash IFR, data flash IFR, or version ID.
0x07	Program Phrase	×	×		Program 8 bytes in a program flash block or a data flash block.
0x08	Erase Flash Block	×	×		Erase a program flash block or data flash block. An erase of any flash block is only possible when unprotected. FlexNVM block must not be partitioned for EEPROM.
0x09	Erase Flash Sector	×	×		Erase all bytes in a program flash or data flash sector.
0x0B	Program Section	×	×	×	Program data from the Section Program Buffer to a program flash or data flash block.
0x40	Read 1s All Blocks	×	×		Verify that all program flash, data flash blocks, EEPROM backup data records, and data flash IFR are erased then release MCU security.
0x41	Read Once	IFR			Read 8 bytes of a dedicated 64 byte field in the program flash 0 IFR.

Table continues on the next page...

Chapter 16 Flash Memory Module (FTFE)

FCMD	Command	Program flash 0	Data flash	FlexRAM	Function
0x43	Program Once	IFR			One-time program of 8 bytes of a dedicated 64-byte field in the program flash 0 IFR.
0x44	Erase All Blocks	×	×	×	Erase all program flash blocks, data flash blocks, FlexRAM, EEPROM backup data records, and data flash IFR. Then, verify-erase and release MCU security.
					NOTE: An erase is only possible when all memory locations are unprotected.
0x45	Verify Backdoor Access Key	×			Release MCU security after comparing a set of user-supplied security keys to those stored in the program flash.
0x49	Erase All Blocks Unsecure	×	×	×	Erase all program flash blocks, data flash blocks, FlexRAM, EEPROM backup data records, and data flash IFR. Then, verify-erase, program the security byte to the unsecure state, and release MCU security.
0x4A	Read 1s All Execute-only Segments	x			Verify that all program flash execute-only (XA) segments are erased then release flash access control.
0x4B	Erase All Execute- only Segments	х			Erase all program flash execute-only (XA) segments then release flash access control.

Table continues on the next page...

Functional Description

FCMD	Command	Program flash 0	Data flash	FlexRAM	Function
0x80	Program Partition		IFR, ×	×	Program the FlexNVM Partition Code and EEPROM Data Set Size into the data flash IFR. format all EEPROM backup data sectors allocated for EEPROM, initialize the FlexRAM.
0x81	Set FlexRAM Function		×	×	Switches FlexRAM function between RAM and EEPROM. When switching to EEPROM, FlexNVM is not available while valid data records are being copied from EEPROM backup to FlexRAM.

16.5.9.3 Allowed simultaneous flash operations

Only the operations marked 'OK' in the following table are permitted to run simultaneously on the program flash, data flash, and FlexRAM memories. Some operations cannot be executed simultaneously because certain hardware resources are shared by the memories. The priority has been placed on permitting program flash reads while program and erase operations execute on the FlexNVM and FlexRAM. This provides read (program flash) while write (FlexNVM, FlexRAM) functionality.

Table 16-6. Allowed Simultaneous Memory Operations

		Р	rogram flas	sh	Data flash			FlexRAM		
		Read	Program Phrase	Erase Flash Sector ¹	Read	Program Phrase	Erase Flash Sector ¹	Read	E-Write ²	R-Write ³
Program flash	Read					OK	OK		OK	
	Program Phrase				ОК			ОК		ОК
	Erase Flash Sector ¹				ОК			ОК		ОК

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Table 16-6.	Allowed Simultaneous Memory	y Operations	(continued)
-------------	-----------------------------	--------------	-------------

		Р	rogram flas	sh		Data flash			FlexRAM	
		Read	Program Phrase	Erase Flash Sector ¹	Read	Program Phrase	Erase Flash Sector ¹	Read	E-Write ²	R-Write ³
	Read		OK	OK						
Data	Program Phrase	ОК						ОК		ОК
flash	Erase Flash Sector ¹	ОК						ОК		ОК
	Read		ОК	OK		ОК	ОК			
FlexRAM	E-Write ²	OK								
	R-Write ³		OK	OK		ОК	OK			

- 1. Also applies to Erase Flash Block
- 2. When FlexRAM configured for EEPROM (EEERDY=1).
- 3. When FlexRAM configured as traditional RAM (RAMRDY=1); single cycle operation.

16.5.10 Margin Read Commands

The Read-1s commands (Read 1s All Blocks, Read 1s Block, Read 1s Section, Read 1s All Execute-only Segments) and the Program Check command have a margin choice parameter that allows the user to apply non-standard read reference levels to the program flash and data flash array reads performed by these commands. Using the preset 'user' and 'factory' margin levels, these commands perform their associated read operations at tighter tolerances than a 'normal' read. These non-standard read levels are applied only during the command execution. All simple (uncommanded) flash array reads to the MCU always use the standard, un-margined, read reference level.

Only the 'normal' read level should be employed during normal flash usage. The non-standard, 'user' and 'factory' margin levels should be employed only in special cases. They can be used during special diagnostic routines to gain confidence that the device is not suffering from the end-of-life data loss customary of flash memory devices.

Erased ('1') and programmed ('0') bit states can degrade due to elapsed time and data cycling (number of times a bit is erased and re-programmed). The lifetime of the erased states is relative to the last erase operation. The lifetime of the programmed states is measured from the last program time.

The 'user' and 'factory' levels become, in effect, a minimum safety margin; i.e. if the reads pass at the tighter tolerances of the 'user' and 'factory' margins, then the 'normal' reads have at least this much safety margin before they experience data loss.

The 'user' margin is a small delta to the normal read reference level. 'User' margin levels can be employed to check that flash memory contents have adequate margin for normal level read operations. If unexpected read results are encountered when checking flash memory contents at the 'user' margin levels, loss of information might soon occur during 'normal' readout.

The 'factory' margin is a bigger deviation from the norm, a more stringent read criteria that should only be attempted immediately (or very soon) after completion of an erase or program command, early in the cycling life. 'Factory' margin levels can be used to check that flash memory contents have adequate margin for long-term data retention at the normal level setting. If unexpected results are encountered when checking flash memory contents at 'factory' margin levels, the flash memory contents should be erased and reprogrammed.

CAUTION

Factory margin levels must only be used during verify of the initial factory programming.

16.5.11 Flash command descriptions

This section describes all flash commands that can be launched by a command write sequence. The FTFE sets the FSTAT[ACCERR] bit and aborts the command execution if any of the following illegal conditions occur:

- There is an unrecognized command code in the FCCOB FCMD field.
- There is an error in a FCCOB field for the specific commands. Refer to the error handling table provided for each command.

Ensure that the ACCERR and FPVIOL bits in the FSTAT register are cleared prior to starting the command write sequence. As described in Launch the Command by Clearing CCIF, a new command cannot be launched while these error flags are set.

Do not attempt to read a flash block while the FTFE is running a command (CCIF = 0) on that same block. The FTFE may return invalid data to the MCU with the collision error flag (FSTAT[RDCOLERR]) set.

When required by the command, address bit 23 selects between program flash memory (=0) and data flash memory (=1).

CAUTION

Flash data must be in the erased state before being programmed. Cumulative programming of bits (adding more zeros) is not allowed.

16.5.11.1 Read 1s Block command

The Read 1s Block command checks to see if an entire program flash or data flash block has been erased to the specified margin level. The FCCOB flash address bits determine which block is erase-verified.

 FCCOB Number
 FCCOB Contents [7:0]

 0
 0x00 (RD1BLK)

 1
 Flash address [23:16] in the flash block to be verified

 2
 Flash address [15:8] in the flash block to be verified

 3
 Flash address [7:0]¹ in the flash block to be verified

 4
 Read-1 Margin Choice

Table 16-7. Read 1s Block Command FCCOB Requirements

After clearing CCIF to launch the Read 1s Block command, the FTFE sets the read margin for 1s according to Table 16-8 and then reads all locations within the selected program flash or data flash block.

When the data flash is targeted, DEPART must be set for no EEPROM, else the Read 1s Block command aborts setting the FSTAT[ACCERR] bit. If the FTFE fails to read all 1s (i.e. the flash block is not fully erased), the FSTAT[MGSTAT0] bit is set. The CCIF flag sets after the Read 1s Block operation has completed.

Read Margin Choice	Margin Level Description
0x00	Use the 'normal' read level for 1s
0x01	Apply the 'User' margin to the normal read-1 level
0x02	Apply the 'Factory' margin to the normal read-1 level

Table 16-8. Margin Level Choices for Read 1s Block

Table 16-9. Read 1s Block Command Error Handling

Error Condition	Error Bit
Command not available in current mode/security	FSTAT[ACCERR]
An invalid margin choice is specified	FSTAT[ACCERR]

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

^{1.} Must be 64-bit aligned (Flash address [2:0] = 000).

Table 16-9. Read 1s Block Command Error Handling (continued)

Error Condition	Error Bit
Program flash is selected and the address is out of program flash range	FSTAT[ACCERR]
Data flash is selected and the address is out of data flash range	FSTAT[ACCERR]
Data flash is selected with EEPROM enabled	FSTAT[ACCERR]
Flash address is not 64-bit aligned	FSTAT[ACCERR]
Read-1s fails	FSTAT[MGSTAT0]

16.5.11.2 Read 1s Section command

The Read 1s Section command checks if a section of program flash or data flash memory is erased to the specified read margin level. The Read 1s Section command defines the starting address and the number of phrases to be verified.

Table 16-10. Read 1s Section Command FCCOB Requirements

FCCOB Number	FCCOB Contents [7:0]
0	0x01 (RD1SEC)
1	Flash address [23:16] of the first phrase to be verified
2	Flash address [15:8] of the first phrase to be verified
3	Flash address [7:0] ¹ of the first phrase to be verified
4	Number of phrases to be verified [15:8]
5	Number of phrases to be verified [7:0]
6	Read-1 Margin Choice

^{1.} Must be 64-bit aligned (Flash address [2:0] = 000).

Upon clearing CCIF to launch the Read 1s Section command, the FTFE sets the read margin for 1s according to Table 16-11 and then reads all locations within the specified section of flash memory.

If the FTFE fails to read all 1s (i.e. the flash section is not erased), the FSTAT(MGSTAT0) bit is set. The CCIF flag sets after the Read 1s Section operation completes.

Table 16-11. Margin Level Choices for Read 1s Section

Read Margin Choice	Margin Level Description
0x00	Use the 'normal' read level for 1s
0x01	Apply the 'User' margin to the normal read-1 level
0x02	Apply the 'Factory' margin to the normal read-1 level

329

Table 16-12. Read 1s Section Command Error Handling

Error Condition	Error Bit
Command not available in current mode/security	FSTAT[ACCERR]
An invalid margin code is supplied	FSTAT[ACCERR]
An invalid flash address is supplied FSTAT[
Flash address is not 64-bit aligned	FSTAT[ACCERR]
The requested section crosses a flash block boundary FSTAT[ACCEI	
The requested number of phrases is zero	FSTAT[ACCERR]
Read-1s fails	FSTAT[MGSTAT0]

16.5.11.3 Program Check command

The Program Check command tests a previously programmed program flash or data flash longword to see if it reads correctly at the specified margin level.

Table 16-13. Program Check Command FCCOB Requirements

FCCOB Number	FCCOB Contents [7:0]	
0	0x02 (PGMCHK)	
1	Flash address [23:16]	
2	Flash address [15:8]	
3	Flash address [7:0] ¹	
4	Margin Choice	
8	Byte 0 expected data	
9	Byte 1 expected data	
A	Byte 2 expected data	
В	Byte 3 expected data	

1. Must be longword aligned (Flash address [1:0] = 00).

Upon clearing CCIF to launch the Program Check command, the FTFE sets the read margin for 1s based on the provided margin choice according to Table 16-14. The Program Check operation then reads the specified longword, and compares the actual read data to the expected data provided by the FCCOB. If the comparison at margin-1 fails, the MGSTAT0 bit is set.

The FTFE will then set the read margin for 0s based on the provided margin choice. The Program Check operation will then read the specified longword and compare the actual read data to the expected data provided by the FCCOB. If the comparison at margin-0 fails, the MGSTAT0 bit will be set. The CCIF flag will set after the Program Check operation has completed.

The starting address must be longword aligned (the lowest two bits of the byte address must be 00):

- Byte 0 data is expected at the supplied 32-bit aligned address,
- Byte 1 data is expected at byte address specified + 0b01,
- Byte 2 data is expected at byte address specified + 0b10, and
- Byte 3 data is expected at byte address specified + 0b11.

NOTE

See the description of margin reads, Margin Read Commands

Table 16-14. Margin Level Choices for Program Check

Read Margin Choice	Margin Level Description
0x01	Read at 'User' margin-1 and 'User' margin-0
0x02	Read at 'Factory' margin-1 and 'Factory' margin-0

Table 16-15. Program Check Command Error Handling

Error Condition	Error Bit
Command not available in current mode/security	FSTAT[ACCERR]
An invalid flash address is supplied	FSTAT[ACCERR]
Flash address is not longword aligned	FSTAT[ACCERR]
An invalid margin choice is supplied	FSTAT[ACCERR]
Flash address is located in an XA controlled segment and the Erase All Blocks, Erase All Blocks Unsecure or the Read 1s All Blocks command has not successfully completed since the last reset	FSTAT[FPVIOL]
Either of the margin reads does not match the expected data	FSTAT[MGSTAT0]

16.5.11.4 Read Resource Command

330

The Read Resource command is provided for the user to read data from special-purpose memory resources located within the Flash module. The special-purpose memory resources available include program flash IFR, data flash IFR space, and the Version ID field. The Version ID field contains an 8 byte code that indicates a specific FTFE implementation.

Table 16-16. Read Resource Command FCCOB Requirements

FCCOB Number	FCCOB contents [7:0]
0	0x03 (RDRSRC)
1	Flash address [23:16]
2	Flash address [15:8]

Table continues on the next page...

Table 16-16. Read Resource Command FCCOB Requirements (continued)

FCCOB Number	FCCOB contents [7:0]
3	Flash address [7:0] ¹
4	Resource select code (see Table 16-17)
	Returned values
4	Read Data [64:56]
5	Read Data [55:48]
6	Read Data [47:40]
7	Read Data [39:32]
8	Read Data [31:24]
9	Read Data [23:16]
Α	Read Data [15:8]
В	Read Data [7:0]

^{1.} Must be 64-bit aligned (Flash address [2:0] = 000).

Table 16-17. Read Resource Select Codes

Resource Select Code	Description	Resource Size	Local Address Range
0x00	Program Flash 0 IFR	1024 Bytes	0x00_0000 - 0x00_03FF
0x00	Data Flash 0 IFR	1024 Bytes	0x80_0000 - 0x80_03FF
0x01	Version ID	8 Bytes	0x00_0008 - 0x00_000F

After clearing CCIF to launch the Read Resource command, eight consecutive bytes are read from the selected resource at the provided relative address and stored in the FCCOB register. The CCIF flag will set after the Read Resource operation has completed. The Read Resource command exits with an access error if an invalid resource code is provided or if the address for the applicable area is out-of-range.

Table 16-18. Read Resource Command Error Handling

Error Condition	Error Bit
Command not available in current mode/security	FSTAT[ACCERR]
An invalid resource code is entered	FSTAT[ACCERR]
Flash address is out-of-range for the targeted resource.	FSTAT[ACCERR]
Flash address is not 64-bit aligned	FSTAT[ACCERR]

16.5.11.5 Program Phrase command

The Program Phrase command programs eight previously-erased bytes in the program flash memory or in the data flash memory using an embedded algorithm.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

CAUTION

A Flash memory location must be in the erased state before being programmed. Cumulative programming of bits (back-to-back program operations without an intervening erase) within a Flash memory location is not allowed. Re-programming of existing 0s to 0 is not allowed as this overstresses the device.

Table 16-19. Program Phrase Command FCCOB Requirements

FCCOB Number	FCCOB Contents [7:0]
0	0x07 (PGM8)
1	Flash address [23:16]
2	Flash address [15:8]
3	Flash address [7:0] ¹
4	Byte 0 program value
5	Byte 1 program value
6	Byte 2 program value
7	Byte 3 program value
8	Byte 4 program value
9	Byte 5 program value
A	Byte 6 program value
В	Byte 7 program value

1. Must be 64-bit aligned (Flash address [2:0] = 000)

Upon clearing CCIF to launch the Program Phrase command, the FTFE programs the data bytes into the flash using the supplied address. The protection status is always checked. The targeted flash locations must be currently unprotected (see the description of the FPROT registers) to permit execution of the Program Phrase operation.

The programming operation is unidirectional. It can only move NVM bits from the erased state ('1') to the programmed state ('0'). Erased bits that fail to program to the '0' state are flagged as errors in MGSTATO. The CCIF flag is set after the Program Phrase operation completes.

The starting address must be 64-bit aligned (flash address [2:0] = 000):

- Byte 0 data is written to the starting address ('start'),
- Byte 1 data is programmed to byte address start+0b01,
- Byte 2 data is programmed to byte address start+0b10, and
- Byte 3 data is programmed to byte address start+0b11, etc.

333

Table 16-20. Program Phrase Command Error Handling

Error Condition	Error Bit
Command not available in current mode/security	FSTAT[ACCERR]
An invalid flash address is supplied	FSTAT[ACCERR]
Flash address is not 64-bit aligned	FSTAT[ACCERR]
Flash address points to a protected area	FSTAT[FPVIOL]
Flash address is located in an XA controlled segment and the Erase All Blocks, Erase All Blocks Unsecure or the Read 1s All Blocks command has not successfully completed since the last reset	FSTAT[FPVIOL]
Any errors have been encountered during the verify operation.	FSTAT[MGSTAT0]

16.5.11.6 Erase Flash Block Command

The Erase Flash Block operation erases all addresses in a single program flash or data flash block.

Table 16-21. Erase Flash Block Command FCCOB Requirements

FCCOB Number	FCCOB Contents [7:0]
0	0x08 (ERSBLK)
1	Flash address [23:16] in the flash block to be erased
2	Flash address [15:8] in the flash block to be erased
3	Flash address [7:0] ¹ in the flash block to be erased

1. Must be 64-bit aligned (Flash address [2:0] = 000).

Upon clearing CCIF to launch the Erase Flash Block command, the FTFE erases the main array of the selected flash block and verifies that it is erased. When the data flash is targeted, DEPART must be set for no EEPROM (see Table 16-4) else the Erase Flash Block command aborts setting the FSTAT[ACCERR] bit. The Erase Flash Block command aborts and sets the FSTAT[FPVIOL] bit if any region within the block is protected (see the description of the program flash protection (FPROT) registers and the data flash protection (FDPROT) registers). If the erase verify fails, the MGSTAT0 bit in FSTAT is set. The CCIF flag will set after the Erase Flash Block operation has completed.

Table 16-22. Erase Flash Block Command Error Handling

Error Condition	Error Bit
Command not available in current mode/security	FSTAT[ACCERR]
Program flash is selected and the address is out of program flash range	FSTAT[ACCERR]
Data flash is selected and the address is out of data flash range	FSTAT[ACCERR]

Table continues on the next page...

Table 16-22. Erase Flash Block Command Error Handling (continued)

Error Condition	Error Bit
Data flash is selected with EEPROM enabled	FSTAT[ACCERR]
Flash address is not 64-bit aligned	FSTAT[ACCERR]
Any area of the selected flash block is protected	FSTAT[FPVIOL]
The selected program flash block contains an XA controlled segment and the Erase All Blocks, Erase All Blocks Unsecure or the Read 1s All Blocks command has not successfully completed since the last reset	FSTAT[FPVIOL]
Any errors have been encountered during the verify operation ¹	FSTAT[MGSTAT0]

^{1.} User margin read may be run using the Read 1s Block command to verify all bits are erased.

16.5.11.7 Erase Flash Sector command

The Erase Flash Sector operation erases all addresses in a flash sector.

Table 16-23. Erase Flash Sector Command FCCOB Requirements

FCCOB Number	FCCOB Contents [7:0]
0	0x09 (ERSSCR)
1	Flash address [23:16] in the flash sector to be erased
2	Flash address [15:8] in the flash sector to be erased
3	Flash address [7:0] ¹ in the flash sector to be erased

^{1.} Must be 64-bit aligned (Flash address [2:0] = 000).

After clearing CCIF to launch the Erase Flash Sector command, the FTFE erases the selected program flash or data flash sector and then verifies that it is erased. The Erase Flash Sector command aborts if the selected sector is protected (see the description of the FPROT registers). If the erase-verify fails the FSTAT[MGSTAT0] bit is set. The CCIF flag is set after the Erase Flash Sector operation completes. The Erase Flash Sector command is suspendable (see the FCNFG[ERSSUSP] bit and Figure 16-11).

Table 16-24. Erase Flash Sector Command Error Handling

Error Condition	Error Bit
Command not available in current mode/security	FSTAT[ACCERR]
An invalid Flash address is supplied	FSTAT[ACCERR]
Flash address is not 64-bit aligned	FSTAT[ACCERR]
The selected program flash or data flash sector is protected	FSTAT[FPVIOL]
The selected program flash sector is located in an XA controlled segment and the Erase All Blocks, Erase All Blocks Unsecure or the Read 1s All Blocks command has not successfully completed since the last reset	FSTAT[FPVIOL]
Any errors have been encountered during the verify operation ¹	FSTAT[MGSTAT0]

335

1. User margin read may be run using the Read 1s Section command to verify all bits are erased.

16.5.11.7.1 Suspending an Erase Flash Sector Operation

To suspend an Erase Flash Sector operation set the FCNFG[ERSSUSP] bit when CCIF, ACCERR, and FPVIOL are clear and the CCOB command field holds the code for the Erase Flash Sector command. During the Erase Flash Sector operation (see Erase Flash Sector command), the flash samples the state of the ERSSUSP bit at convenient points. If the FTFE detects that the ERSSUSP bit is set, the Erase Flash Sector operation is suspended and the FTFE sets CCIF. While ERSSUSP is set, all writes to flash registers are ignored except for writes to the FSTAT and FCNFG registers.

If an Erase Flash Sector operation effectively completes before the FTFE detects that a suspend request has been made, the FTFE clears the ERSSUSP bit prior to setting CCIF. When an Erase Flash Sector operation has been successfully suspended, the FTFE sets CCIF and leaves the ERSSUSP bit set. While CCIF is set, the ERSSUSP bit can only be cleared to prevent the withdrawal of a suspend request before the FTFE has acknowledged it.

16.5.11.7.2 Resuming a Suspended Erase Flash Sector Operation

If the ERSSUSP bit is still set when CCIF is cleared to launch the next command, the previous Erase Flash Sector operation resumes. The FTFE acknowledges the request to resume a suspended operation by clearing the ERSSUSP bit. A new suspend request can then be made by setting ERSSUSP. A single Erase Flash Sector operation can be suspended and resumed multiple times.

There is a minimum elapsed time limit of 4.3 msec between the request to resume the Erase Flash Sector operation (CCIF is cleared) and the request to suspend the operation again (ERSSUSP is set). This minimum time period is required to ensure that the Erase Flash Sector operation will eventually complete. If the minimum period is continually violated, i.e. the suspend requests come repeatedly and too quickly, no forward progress is made by the Erase Flash Sector algorithm. The resume/suspend sequence runs indefinitely without completing the erase.

16.5.11.7.3 Aborting a Suspended Erase Flash Sector Operation

The user may choose to abort a suspended Erase Flash Sector operation by clearing the ERSSUSP bit prior to clearing CCIF for the next command launch. When a suspended operation is aborted, the FTFE starts the new command using the new FCCOB contents.

While FCNFG[ERSSUSP] is set, a write to the FlexRAM while FCNFG[EEERDY] is set clears ERSSUSP and aborts the suspended operation. The FlexRAM write operation is executed by the FTFE.

Note

Aborting the erase leaves the bitcells in an indeterminate, partially-erased state. Data in this sector is not reliable until a new erase command fully completes.

The following figure shows how to suspend and resume the Erase Flash Sector operation.

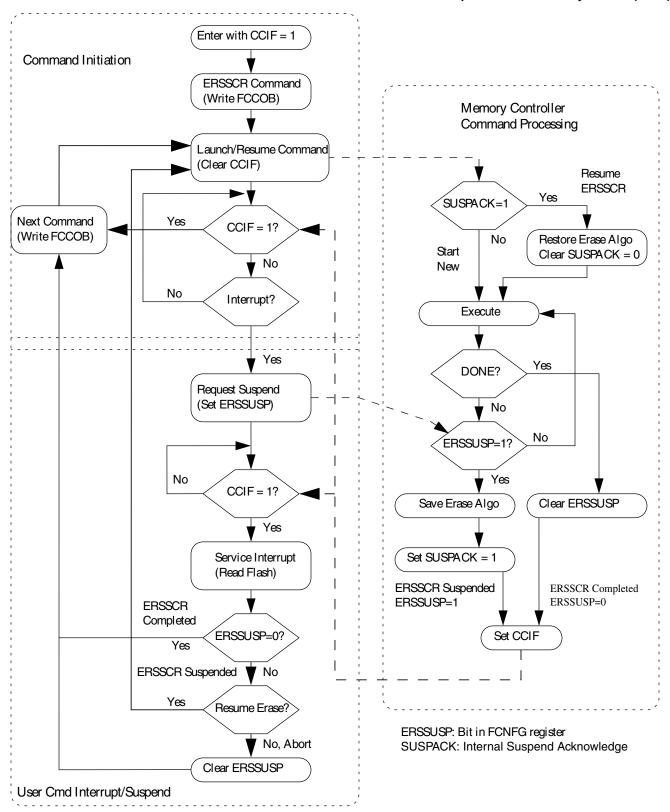


Figure 16-11. Suspend and Resume of Erase Flash Sector Operation

16.5.11.8 Program Section command

The Program Section operation programs the data found in the section program buffer to previously erased locations in the flash memory using an embedded algorithm. Data is preloaded into the section program buffer by writing to the FlexRAM while it is set to function as a programming acceleration RAM (see Flash sector programming).

The section program buffer is limited to the lower quarter of the programming acceleration RAM (relative byte addresses 0x0000-0x01FF - be sure to check your device specific memory map for the location of the programming acceleration RAM or FlexRAM). Data written to the remainder of the programming acceleration RAM is ignored and may be overwritten during Program Section command execution.

CAUTION

A flash memory location must be in the erased state before being programmed. Cumulative programming of bits (back-toback program operations without an intervening erase) within a flash memory location is not allowed. Re-programming of existing 0s to 0 is not allowed as this overstresses the device.

FCCOB Number	FCCOB Contents [7:0]
0	0x0B (PGMSEC)
1	Flash address [23:16]
2	Flash address [15:8]
3	Flash address [7:0] ¹
4	Number of phrases to program [15:8]
5	Number of phrases to program [7:0]

Table 16-25. Program Section Command FCCOB Requirements

After clearing CCIF to launch the Program Section command, the FTFE will block access to the FlexRAM and program the data residing in the Section Program Buffer into the flash memory starting at the flash address provided.

The starting address must be unprotected (see the description of the FPROT registers) to permit execution of the Program Section operation. Programming, which is not allowed to cross a flash sector boundary, continues until all requested phrases have been programmed.

After the Program Section operation has completed, the CCIF flag will set and normal access to the FlexRAM is restored. The contents of the Section Program Buffer are not changed by the Program Section operation.

^{1.} Must be 64-bit aligned (Flash address [2:0] = 000).

Table 16-26. Program Section Command Error Handling

Error Condition	Error Bit
Command not available in current mode/security	FSTAT[ACCERR]
An invalid flash address is supplied	FSTAT[ACCERR]
Flash address is not 64-bit aligned	FSTAT[ACCERR]
The requested section crosses a program flash sector boundary	FSTAT[ACCERR]
The requested number of phrases is zero	FSTAT[ACCERR]
The space required to store data for the requested number of phrases is more than one quarter the size of the FlexRAM	FSTAT[ACCERR]
The FlexRAM is not set to function as a traditional RAM, i.e. set if RAMRDY=0	FSTAT[ACCERR]
The flash address falls in a protected area	FSTAT[FPVIOL]
The requested flash section is located in an XA controlled segment and the Erase All Blocks, Erase All Blocks Unsecure or the Read 1s All Blocks command has not successfully completed since the last reset	FSTAT[FPVIOL]
Any errors have been encountered during the verify operation	FSTAT[MGSTAT0]

16.5.11.8.1 Flash sector programming

The process of programming an entire flash sector using the Program Section command is as follows:

- 1. If required, execute the Set FlexRAM Function command to make the FlexRAM available as traditional RAM and initialize the FlexRAM to all ones.
- 2. Launch the Erase Flash Sector command to erase the flash sector to be programmed.
- 3. Beginning with the starting address of the FlexRAM, sequentially write enough data to the RAM to fill an entire flash sector, or as much data is allowed due to RAM size versus flash sector size. This area of the RAM serves as the section program buffer.

NOTE

In step 1, the section program buffer was initialized to all ones, the erased state of the flash memory.

The section program buffer can be written to while the operation launched in step 2 is executing, i.e. while CCIF = 0.

- 4. Execute the Program Section command to program the contents of the section program buffer into the selected flash sector.
- 5. Repeat steps 3 through 4 to complete the entire flash sector, if necessary.
- 6. To program additional flash sectors, repeat steps 2 through 5.
- 7. To restore EEPROM functionality, execute the Set FlexRAM Function command to make the FlexRAM available for EEPROM.

16.5.11.9 Read 1s All Blocks Command

The Read 1s All Blocks command checks if the program flash blocks, data flash blocks, EEPROM backup records, and data flash IFR have been erased to the specified read margin level, if applicable, and releases security if the readout passes, i.e. all data reads as '1'.

Table 16-27. Read 1s All Blocks Command FCCOB Requirements

FCCOB Number	FCCOB Contents [7:0]	
0	0x40 (RD1ALL)	
1	Read-1 Margin Choice	

After clearing CCIF to launch the Read 1s All Blocks command, the FTFE:

- sets the read margin for 1s according to Table 16-28,
- checks the contents of the program flash, data flash, EEPROM backup records, and data flash IFR are in the erased state.

If the FTFE confirms that these memory resources are erased, access control is disabled and security is released by setting the FSEC[SEC] field to the unsecure state. The security byte in the flash configuration field (see Flash configuration field description) remains unaffected by the Read 1s All Blocks command. If the read fails, i.e. all flash memory resources are not in the fully erased state, the FSTAT[MGSTAT0] bit is set.

The EEERDY and RAMRDY bits are clear during the Read 1s All Blocks operation and are restored at the end of the Read 1s All Blocks operation.

The CCIF flag sets after the Read 1s All Blocks operation has completed.

Table 16-28. Margin Level Choices for Read 1s All Blocks

Read Margin Choice	Margin Level Description	
0x00	Use the 'normal' read level for 1s	
0x01	Apply the 'User' margin to the normal read-1 level	
0x02	Apply the 'Factory' margin to the normal read-1 level	

Table 16-29. Read 1s All Blocks Command Error Handling

Error Condition	Error Bit
Command not available in current mode/security	FSTAT[ACCERR]
An invalid margin choice is specified	FSTAT[ACCERR]
Read-1s fails	FSTAT[MGSTAT0]

16.5.11.10 Read Once Command

The Read Once command provides read access to a reserved 96-byte field located in the program flash IFR (see Program flash 0 IFR map and Program Once field). Access to the Program Once field is via 12 records, each 8 bytes long. The Program Once field is programmed using the Program Once command described in Program Once command.

FCCOB Number	FCCOB Contents [7:0]	
0	0x41 (RDONCE)	
1	Program Once record index (0x00 - 0x0B)	
Returned Values		
4	Program Once byte 0 value	
5	Program Once byte 1 value	
6	Program Once byte 2 value	
7	Program Once byte 3 value	
8	Program Once byte 4 value	
9	Program Once byte 5 value	
Α	Program Once byte 6 value	
В	Program Once byte 7 value	

Table 16-30. Read Once Command FCCOB Requirements

After clearing CCIF to launch the Read Once command, an 8-byte Program Once record is read from the program flash IFR and stored in the FCCOB register. The CCIF flag is set after the Read Once operation completes. Valid record index values for the Read Once command range from 0x00 to 0x0B. During execution of the Read Once command, any attempt to read addresses within the program flash block containing this 96-byte field returns invalid data. The Read Once command can be executed any number of times.

Table 16-31. Read Once Command Error Handling

Error Condition	Error Bit
Command not available in current mode/security	FSTAT[ACCERR]
An invalid record index is supplied	FSTAT[ACCERR]

16.5.11.11 Program Once command

The Program Once command enables programming to a reserved 96-byte field in the program flash IFR (see Program flash 0 IFR map and Program Once field). Access to the Program Once field is via 12 records, each 8 bytes long. The Program Once field can be

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

read using the Read Once command (see Read Once Command) or using the Read Resource command (see Read Resource Command). Each Program Once record can be programmed only once since the program flash IFR cannot be erased.

Table 16-32. Program Once Command FCCOB Requirements

FCCOB Number	FCCOB Contents [7:0]	
0	0x43 (PGMONCE)	
1	Program Once record index (0x00 - 0x0B)	
2	Not Used	
3	Not Used	
4	Program Once Byte 0 value	
5	Program Once Byte 1 value	
6	Program Once Byte 2 value	
7	Program Once Byte 3 value	
8	Program Once Byte 4 value	
9	Program Once Byte 5 value	
A	Program Once Byte 6 value	
В	Program Once Byte 7 value	

After clearing CCIF to launch the Program Once command, the FTFE first verifies that the selected record is erased. If erased, then the selected record is programmed using the values provided. The Program Once command also verifies that the programmed values read back correctly. The CCIF flag is set after the Program Once operation has completed.

The reserved program flash IFR location accessed by the Program Once command cannot be erased and any attempt to program one of these records when the existing value is not Fs (erased) is not allowed. Valid record index values for the Program Once command range from 0x00 to 0x0B. During execution of the Program Once command, any attempt to read addresses within program flash returns invalid data.

Table 16-33. Program Once Command Error Handling

Error Condition	Error Bit
Command not available in current mode/security	FSTAT[ACCERR]
An invalid record index is supplied	FSTAT[ACCERR]
The requested record has already been programmed to a non-erased value ¹	FSTAT[ACCERR]
Any errors have been encountered during the verify operation.	FSTAT[MGSTAT0]

^{1.} If a Program Once record is initially programmed to 0xFFFF_FFFF_FFFF, the Program Once command is allowed to execute again on that same record.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018 342 NXP Semiconductors

343

16.5.11.12 Erase All Blocks Command

The Erase All Blocks operation erases all flash memory, initializes the FlexRAM, verifies all memory contents, and releases MCU security.

Table 16-34. Erase All Blocks Command FCCOB Requirements

FCCOB Number	FCCOB Contents [7:0]	
0	0x44 (ERSALL)	

After clearing CCIF to launch the Erase All Blocks command, the FTFE erases all program flash memory, data flash memory, data flash IFR space, EEPROM backup memory, and FlexRAM, then verifies that all are erased.

If the FTFE verifies that all flash memories and the FlexRAM were properly erased, access control is disabled and security is released by setting the FSEC[SEC] field to the unsecure state and the FCNFG[RAMRDY] bit is set. The Erase All Blocks command aborts if any flash or FlexRAM region is protected. The security byte and all other contents of the flash configuration field (see Flash configuration field description) are erased by the Erase All Blocks command. If the erase-verify fails, the FSTAT[MGSTAT0] bit is set. The CCIF flag is set after the Erase All Blocks operation completes.

Access control determined by the contents of the FXACC registers will not block execution of the Erase All Blocks command. While most Flash memory will be erased, the program flash 0 IFR space containing the Program Once XACC and SACC fields will not be erased and, therefore, the contents of the Program Once XACC and SACC fields will not change. The contents of the FXACC and FSACC registers will not be impacted by the execution of the Erase All Blocks command. After completion of the Erase All Blocks command, access control is disabled until the next reset of the flash module or the Read 1s All Blocks command is executed and fails (FSTAT[MGSTAT0] is set).

Table 16-35. Erase All Blocks Command Error Handling

Error Condition	Error Bit
Command not available in current mode/security	FSTAT[ACCERR]
Any region of the program flash memory, data flash memory, or FlexRAM is protected	FSTAT[FPVIOL]
Any errors have been encountered during the verify operation ¹	FSTAT[MGSTAT0]

1. User margin read may be run using the Read 1s All Blocks command to verify all bits are erased.

NXP Semiconductors

16.5.11.12.1 Triggering an erase all external to the flash module

The functionality of the Erase All Blocks/Erase All Blocks Unsecure command is also available in an uncommanded fashion outside of the flash memory. Refer to the device's Chip Configuration details for information on this functionality.

Before invoking the external erase all function, the FCCOB0 register must not contain 0x44. When invoked, the erase-all function erases all program flash memory, data flash memory, data flash IFR space, EEPROM backup, and FlexRAM regardless of the state of the FSTAT[ACCERR and FPVIOL] flags or the protection settings. If the post-erase verify passes, access control determined by the contents of the FXACC registers is disabled and the routine releases security by setting the FSEC[SEC] field register to the unsecure state and the FCNFG[RAMRDY] bit sets. The security byte in the Flash Configuration Field is also programmed to the unsecure state. The status of the erase-all request is reflected in the FCNFG[ERSAREQ] bit. The FCNFG[ERSAREQ] bit is cleared once the operation completes and the normal FSTAT error reporting, except FPVIOL, is available as described in Erase All Blocks Command/Erase All Blocks Unsecure Command.

16.5.11.13 Verify Backdoor Access Key command

Execution of the Verify Backdoor Access Key command is qualified by the FSEC[KEYEN] bits. The Verify Backdoor Access Key command releases security if user-supplied keys in the FCCOB match those stored in the Backdoor Comparison Key bytes of the Flash Configuration Field. The column labeled Flash Configuration Field offset address shows the location of the matching byte in the Flash Configuration Field.

Table 16-36. Verify Backdoor Access Key Command FCCOB Requirements

FCCOB Number	FCCOB Contents [7:0]	Flash Configuration Field Offset Address
0	0x45 (VFYKEY)	
1-3	Not Used	
4	Key Byte 0	0x0_0003
5	Key Byte 1	0x0_0002
6	Key Byte 2	0x0_0001
7	Key Byte 3	0x0_0000
8	Key Byte 4	0x0_0007
9	Key Byte 5	0x0_0006
А	Key Byte 6	0x0_0005
В	Key Byte 7	0x0_0004

345

After clearing CCIF to launch the Verify Backdoor Access Key command, the FTFE checks the FSEC[KEYEN] bits to verify that this command is enabled. If not enabled, the FTFE sets the FSTAT[ACCERR] bit and terminates. If the command is enabled, the FTFE compares the key provided in FCCOB to the backdoor comparison key in the Flash Configuration Field. If the backdoor keys match, the FSEC[SEC] field is changed to the unsecure state and security is released. If the backdoor keys do not match, security is not released and all future attempts to execute the Verify Backdoor Access Key command are immediately aborted and the FSTAT[ACCERR] bit is (again) set to 1 until a reset of the FTFE module occurs. If the entire 8-byte key is all zeros or all ones, the Verify Backdoor Access Key command fails with an access error. The CCIF flag is set after the Verify Backdoor Access Key operation completes.

Table 16-37. Verify Backdoor Access Key Command Error Handling

Error Condition	Error Bit
Command not available in current mode/security	FSTAT[ACCERR]
The supplied key is all-0s or all-Fs	FSTAT[ACCERR]
An incorrect backdoor key is supplied	FSTAT[ACCERR]
Backdoor key access has not been enabled (see the description of the FSEC register)	FSTAT[ACCERR]
This command is launched and the backdoor key has mismatched since the last power down reset	FSTAT[ACCERR]

16.5.11.14 Erase All Blocks Unsecure Command

The Erase All Blocks Unsecure operation erases all flash memory, initializes the FlexRAM, verifies all memory contents, programs the security byte in the Flash Configuration Field to the unsecure state, and releases MCU security.

Table 16-38. Erase All Blocks Unsecure Command FCCOB Requirements

FCCOB Number	FCCOB Contents [7:0]	
0	0x49 (ERSALLU)	

After clearing CCIF to launch the Erase All Blocks Unsecure command, the FTFE erases all program flash memory, data flash memory, data flash IFR space, EEPROM backup memory, and FlexRAM, then verifies that all are erased.

If the FTFE verifies that all flash memories and the FlexRAM were properly erased, access control is disabled and security is released by setting the FSEC[SEC] field to the unsecure state, the security byte (see Flash configuration field description) is programmed to the unsecure state by the Erase All Blocks Unsecure command, and the

FCNFG[RAMRDY] bit is set. If the erase or program verify fails, the FSTAT[MGSTAT0] bit is set. The CCIF flag is set after the Erase All Blocks Unsecure operation completes.

Access control determined by the contents of the FXACC registers will not block execution of the Erase All Blocks Unsecure command. While most Flash memory will be erased, the program flash 0 IFR space containing the Program Once XACC and SACC fields will not be erased and, therefore, the contents of the Program Once XACC and SACC fields will not change. The contents of the FXACC and FSACC registers will not be impacted by the execution of the Erase All Blocks Unsecure command. After completion of the Erase All Blocks Unsecure command, access control is disabled until the next reset of the flash module or the Read 1s All Blocks command is executed and fails (FSTAT[MGSTAT0] is set).

Table 16-39. Erase All Blocks Unsecure Command Error Handling

Error Condition	Error Bit
Command not available in current mode/security	FSTAT[ACCERR]
Any errors have been encountered during erase or program verify operations	FSTAT[MGSTAT0]

16.5.11.15 Read 1s All Execute-only Segments Command

The Read 1s All Execute-only Segments command checks if the program flash execute-only segments defined by the FXACC registers have been erased to the specified read margin level, if applicable, and releases flash access control if the readout passes, i.e. all data reads as '1'.

Table 16-40. Read 1s All Execute-only Segments Command FCCOB Requirements

FCCOB Number	FCCOB Contents [7:0]
0	0x4A (RD1XA)
1	Read-1 Margin Choice

After clearing CCIF to launch the Read 1s All Execute-only Segments command, the flash memory module :

- sets the read margin for 1s according to Table 16-41,
- checks the contents of the program flash execute-only segments are in the erased state.

If the flash memory module confirms that these segments are erased, flash access control is disabled until the next reset or, after programming any of the execute-only segments, the Read 1s All Execute-only Segments command is executed and fails with the FSTAT[MGSTAT0] bit set. If the read fails, i.e. all segments are not in the fully erased state, the FSTAT[MGSTAT0] bit is set.

The CCIF flag sets after the Read 1s All Execute-only Segments operation has completed.

Table 16-41. Margin Level Choices for Read 1s All Execute-only Segments

Read Margin Choice	Margin Level Description	
0x00	Use the 'normal' read level for 1s	
0x01 Apply the 'User' margin to the normal read-1 level		
0x02 Apply the 'Factory' margin to the normal read-1 level		

Table 16-42. Read 1s All Execute-only Segments Command Error Handling

Error Condition	Error Bit
Command not available in current mode/security	FSTAT[ACCERR]
An invalid margin choice is specified	FSTAT[ACCERR]
Read-1s fails	FSTAT[MGSTAT0]

16.5.11.16 Erase All Execute-only Segments Command

The Erase All Execute-only Segments operation erases all program flash execute-only segments defined by the FXACC registers, verifies all segments are erased, and releases flash access control.

Table 16-43. Erase All Execute-only Segments Command FCCOB Requirements

FCCOB Number	FCCOB Contents [7:0]	
0	0x4B (ERSXA)	

After clearing CCIF to launch the Erase All Execute-only Segments command, the flash memory module erases all program flash execute-only segments, then verifies that all segments are erased.

If the flash memory module verifies that all segments were properly erased, flash access control is disabled until the next reset or, after programming any of the execute-only segments, the Read 1s All Execute-only Segments command is executed and fails with the FSTAT[MGSTAT0] bit set. The Erase All Execute-only Segments command aborts if

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

any XA controlled segment is protected. If the erase-verify fails, the FSTAT[MGSTAT0] bit is set. The CCIF flag is set after the Erase All Execute-only Segments operation completes.

Access control determined by the contents of the FXACC registers will not block execution of the Erase All Execute-only Segments command. While all XA controlled segments will be erased, the program flash IFR space containing the Program Once XACC fields will not be erased and, therefore, the contents of the Program Once XACC fields will not change. The contents of the FXACC registers will not be impacted by the execution of the Erase All Execute-only Segments command.

Table 16-44. Erase All Execute-only Segments Command Error Handling

Error Condition	Error Bit
Command not available in current mode/security	FSTAT[ACCERR]
Any XA controlled segment in the program flash memory is protected	FSTAT[FPVIOL]
Any errors have been encountered during the verify operation	FSTAT[MGSTAT0]

16.5.11.17 Program Partition command

The Program Partition command prepares the FlexNVM block for use as data flash, EEPROM backup, or a combination of both and initializes the FlexRAM. The Program Partition command must not be launched from flash memory, since flash memory resources are not accessible during Program Partition command execution.

CAUTION

While different partitions of the FlexNVM are available, the intention is that a single partition choice is used throughout the entire lifetime of a given application. The FlexNVM Partition Code choices affect the endurance and data retention characteristics of the device.

Table 16-45. Program Partition Command FCCOB Requirements

FCCOB Number	FCCOB Contents [7:0]	
0	0x80 (PGMPART)	
1	Not Used	
2	Not Used	
	FlexRAM load during reset option (only bit 0 used):	
3	0 - FlexRAM loaded with valid EEPROM data during reset sequence	
	1 - FlexRAM not loaded during reset sequence	

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Table 16-45. Program Partition Command FCCOB Requirements (continued)

FCCOB Number	FCCOB Contents [7:0]	
4	EEPROM Data Set Size Code ¹	
5	FlexNVM Partition Code ²	

- 1. See Valid EEPROM Data Set Size Codes and EEPROM Data Set Size
- 2. See Valid FlexNVM Partition Codes and FlexNVM partition code

Table 16-46. Valid EEPROM Data Set Size Codes

EEPROM Data Set Size Code (FCCOB4) ¹		EEPROM Data Set Size (Bytes)
EEESPLIT (FCCOB4[5:4)]	EEESIZE (FCCOB4[3:0])	
11	0xF	02
11	0x9	32
11	0x8	64
11	0x7	128
11	0x6	256
11	0x5	512
11	0x4	1,024
11	0x3	2,048

- 1. FCCOB4[7:6] = 00
- 2. EEPROM Data Set Size must be set to 0 Bytes when the FlexNVM Partition Code is set for no EEPROM.

Table 16-47. Valid FlexNVM Partition Codes

FlexNVM Partition Code DEPART (FCCOB5[3:0) ¹	Data flash Size (Kbytes)	EEPROM-backup Size (Kbytes)
0000	32	0
0011	0	32
1000	0	32
1001	8	24
1011	32	0

1. FCCOB5[7:4] = 0000

After clearing CCIF to launch the Program Partition command, the FTFE first verifies that the EEPROM Data Set Size Code and FlexNVM Partition Code in the data flash IFR are erased. If erased, the Program Partition command erases the contents of the FlexNVM memory. If the FlexNVM is to be partitioned for EEPROM backup, the allocated EEPROM backup sectors are formatted for EEPROM use. Finally, the partition codes are programmed into the data flash IFR using the values provided. The Program Partition command also verifies that the partition codes read back correctly after programming. The CCIF flag is set after the Program Partition operation completes.

Prior to launching the Program Partition command, the data flash IFR must be in an erased state, which can be accomplished by executing the Erase All Blocks command or by an external request (see Erase All Blocks Command). The EEPROM Data Set Size Code and FlexNVM Partition Code are read using the Read Resource command (see Read Resource Command).

Table 16-48. Program Partition Command Error Handling

Error Condition	Error Bit
Command not available in current mode/security	FSTAT[ACCERR]
The EEPROM data size and FlexNVM partition code bytes are not initially 0xFFFF	FSTAT[ACCERR]
Invalid EEPROM Data Set Size Code is entered (see Table 16-46 for valid codes)	FSTAT[ACCERR]
Invalid FlexNVM Partition Code is entered (see Table 16-47 for valid codes)	FSTAT[ACCERR]
FlexNVM Partition Code = full data flash (no EEPROM) and EEPROM Data Set Size Code allocates FlexRAM for EEPROM	FSTAT[ACCERR]
FlexNVM Partition Code allocates space for EEPROM backup, but EEPROM Data Set Size Code allocates no FlexRAM for EEPROM	FSTAT[ACCERR]
FCCOB4[7:6] != 00	FSTAT[ACCERR]
FCCOB5[7:4] != 0000	FSTAT[ACCERR]
Any errors have been encountered during the verify operation	FSTAT[MGSTAT0]

16.5.11.18 Set FlexRAM Function command

The Set FlexRAM Function command changes the function of the FlexRAM:

- When not partitioned for EEPROM, the FlexRAM is typically used as traditional RAM.
- When partitioned for EEPROM, the FlexRAM is typically used to store EEPROM data.

Table 16-49. Set FlexRAM Function Command FCCOB Requirements

FCCOB Number	FCCOB Contents [7:0]
0	0x81 (SETRAM)
4	FlexRAM Function Control Code
1	(see Table 16-50)

Table 16-50. FlexRAM Function Control

FlexRAM Function Control Code	Action
0xFF	Make FlexRAM available as RAM:
	Clear the FCNFG[RAMRDY] and FCNFG[EEERDY] flags

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

351

Table 16-50. FlexRAM Function Control (continued)

FlexRAM Function Control Code	Action
	Write a background of ones to all FlexRAM locations Set the FCNFG[RAMRDY] flag
0x00	Make FlexRAM available for EEPROM: Clear the FCNFG[RAMRDY] and FCNFG[EEERDY] flags Write a background of ones to all FlexRAM locations Copy-down existing EEPROM data to FlexRAM Set the FCNFG[EEERDY] flag

After clearing CCIF to launch the Set FlexRAM Function command, the FTFE sets the function of the FlexRAM based on the FlexRAM Function Control Code.

When making the FlexRAM available as traditional RAM, the FTFE clears the FCNFG[EEERDY] and FCNFG[RAMRDY] flags, overwrites the contents of the entire FlexRAM with a background pattern of all ones, and sets the FCNFG[RAMRDY] flag. The state of the EPROT register does not prevent the FlexRAM from being overwritten. When the FlexRAM is set to function as a RAM, normal read and write accesses to the FlexRAM are available. When large sections of flash memory need to be programmed, e.g. during factory programming, the FlexRAM can be used as the Section Program Buffer for the Program Section command (see Program Section command).

When making the FlexRAM available for EEPROM, the FTFE clears the FCNFG[RAMRDY] and FCNFG[EEERDY] flags, overwrites the contents of the FlexRAM allocated for EEPROM with a background pattern of all ones, and copies the existing EEPROM data from the EEPROM backup record space to the FlexRAM. After completion of the EEPROM copy-down, the FCNFG[EEERDY] flag is set. When the FlexRAM is set to function as EEPROM, normal read and write access to the FlexRAM is available, but writes to the FlexRAM also invoke EEPROM activity.

The CCIF flag will be set after the Set FlexRAM Function operation has completed.

Table 16-51. Set FlexRAM Function Command Error Handling

Error Condition	Error Bit
Command not available in current mode/security	FSTAT[ACCERR]
FlexRAM Function Control Code is not defined	FSTAT[ACCERR]
FlexRAM Function Control Code is set to make the FlexRAM available for EEPROM, but FlexNVM is not partitioned for EEPROM	FSTAT[ACCERR]

16.5.12 **Security**

The FTFE module provides security information to the MCU based on contents of the FSEC security register. The MCU then limits access to FTFE resources as defined in the device's Chip Configuration details. During reset, the FTFE module initializes the FSEC register using data read from the security byte of the Flash Configuration Field (see Flash configuration field description).

The following fields are available in the FSEC register. Details of the settings are described in the FSEC register description.

Flash security features are discussed further in AN4507: Using the Kinetis Security and Flash Protection Features. Some features described in the application note may not be available on this device.

FSEC field	Description	
KEYEN	Backdoor Key Access	
MEEN	Mass Erase Capability	
FSLACC	Factory Security Level Access	
SEC MCU security		

Table 16-52. FSEC fields

16.5.12.1 Changing the Security State

The security state out of reset can be permanently changed by programming the security byte of the flash configuration field. This assumes that you are starting from a mode where the necessary program flash erase and program commands are available and that the region of the program flash containing the flash configuration field is unprotected. If the flash security byte is successfully programmed, its new value takes effect after the next MCU reset.

16.5.12.1.1 Unsecuring the MCU Using Backdoor Key Access

The MCU can be unsecured by using the backdoor key access feature which requires knowledge of the contents of the 8-byte backdoor key value stored in the Flash Configuration Field (see Flash configuration field description). If the FSEC[KEYEN] bits are in the enabled state, the Verify Backdoor Access Key command (see Verify Backdoor Access Key command) can be run which allows the user to present prospective keys for comparison to the stored keys. If the keys match, the FSEC[SEC] bits are changed to unsecure the MCU. The entire 8-byte key cannot be all 0s or all 1s, i.e. $0x0000_0000_0000_0000$ and $0xFFFF_FFFF_FFFF$ are not accepted by the

353

Verify Backdoor Access Key command as valid comparison values. While the Verify Backdoor Access Key command is active, program flash memory is not available for read access and returns invalid data.

The user code stored in the program flash memory must have a method of receiving the backdoor keys from an external stimulus. This external stimulus would typically be through one of the on-chip serial ports.

If the KEYEN bits are in the enabled state, the MCU can be unsecured by the backdoor key access sequence described below:

- 1. Follow the command sequence for the Verify Backdoor Access Key command as explained in Verify Backdoor Access Key command
- 2. If the Verify Backdoor Access Key command is successful, the MCU is unsecured and the FSEC[SEC] bits are forced to the unsecure state

An illegal key provided to the Verify Backdoor Access Key command prohibits future use of the Verify Backdoor Access Key command. A reset of the MCU is the only method to re-enable the Verify Backdoor Access Key command when a comparison fails.

After the backdoor keys have been correctly matched, the MCU is unsecured by changing the FSEC[SEC] bits. A successful execution of the Verify Backdoor Access Key command changes the security in the FSEC register only. It does not alter the security byte or the keys stored in the Flash Configuration Field (Flash configuration field description). After the next reset of the MCU, the security state of the FTFE module reverts back to the Flash security byte in the Flash Configuration Field. The Verify Backdoor Access Key command sequence has no effect on the program and erase protections defined in the program flash protection registers.

If the backdoor keys successfully match, the unsecured MCU has full control of the contents of the Flash Configuration Field. The MCU may erase the sector containing the Flash Configuration Field and reprogram the flash security byte to the unsecure state and change the backdoor keys to any desired value.

16.5.12.2 Unsecuring the MCU Using Backdoor Key Access

The MCU can be unsecured by using the backdoor key access feature which requires knowledge of the contents of the 8-byte backdoor key value stored in the Flash Configuration Field (see Flash configuration field description). If the FSEC[KEYEN] bits are in the enabled state, the Verify Backdoor Access Key command (see Verify Backdoor Access Key command) can be run which allows the user to present prospective keys for comparison to the stored keys. If the keys match, the FSEC[SEC] bits are changed to

Reset Sequence

unsecure the MCU. The entire 8-byte key cannot be all 0s or all 1s, i.e. $0x0000_0000_0000_0000$ and $0xFFFF_FFFF_FFFF$ are not accepted by the Verify Backdoor Access Key command as valid comparison values. While the Verify Backdoor Access Key command is active, program flash memory is not available for read access and returns invalid data.

The user code stored in the program flash memory must have a method of receiving the backdoor keys from an external stimulus. This external stimulus would typically be through one of the on-chip serial ports.

If the KEYEN bits are in the enabled state, the MCU can be unsecured by the backdoor key access sequence described below:

- 1. Follow the command sequence for the Verify Backdoor Access Key command as explained in Verify Backdoor Access Key command
- 2. If the Verify Backdoor Access Key command is successful, the MCU is unsecured and the FSEC[SEC] bits are forced to the unsecure state

An illegal key provided to the Verify Backdoor Access Key command prohibits future use of the Verify Backdoor Access Key command. A reset of the MCU is the only method to re-enable the Verify Backdoor Access Key command when a comparison fails.

After the backdoor keys have been correctly matched, the MCU is unsecured by changing the FSEC[SEC] bits. A successful execution of the Verify Backdoor Access Key command changes the security in the FSEC register only. It does not alter the security byte or the keys stored in the Flash Configuration Field (Flash configuration field description). After the next reset of the MCU, the security state of the FTFE module reverts back to the Flash security byte in the Flash Configuration Field. The Verify Backdoor Access Key command sequence has no effect on the program and erase protections defined in the program flash protection registers.

If the backdoor keys successfully match, the unsecured MCU has full control of the contents of the Flash Configuration Field. The MCU may erase the sector containing the Flash Configuration Field and reprogram the flash security byte to the unsecure state and change the backdoor keys to any desired value.

16.6 Reset Sequence

On each system reset the FTFE module executes a sequence which establishes initial values for the flash block configuration parameters, FPROT, FDPROT, FEPROT, FOPT, FSEC, FXACC, FSACC, and FACNFG registers and the FCNFG[RAMRDY, EEERDY] bits.

CCIF is cleared throughout the reset sequence. The FTFE module holds off all CPU access for a portion of the reset sequence. Flash reads are possible when the hold is removed. Completion of the reset sequence is marked by setting CCIF which enables flash user commands.

If a reset occurs while any FTFE command is in progress, that command is immediately aborted. The state of the word being programmed or the sector/block being erased is not guaranteed. Commands and operations do not automatically resume after exiting reset.

16.7 Usage Guide

Related application notes on this FTFE module are as follows.

- Production Flash Programming Best Practices for Kinetis K- and L-series MCUs
- Using the Kinetis Security and Flash Protection Features
- Using the Kinetis Family Enhanced EEPROM Functionality
- Robust Over-the-Air Firmware Updates Using Program Flash Memory Swap on Kinetis Microcontrollers
- Using the Kinetis Flash Execute-Only Access Control Feature

Usage Guide

Chapter 17 Clock Distribution

17.1 Introduction

This chapter presents the clock architecture overview of this device, the clock distribution and module clocks, and a clock terminology section. The clocking generation and configuration can be divided into 3 parts:

- 1. Clock sources generation
 - FIRC, SIRC, SOSC, LPFLL, all from the SCG module
 - OSC32
 - LPO from PMC
- 2. Peripheral Clock Controller (PCC)
- 3. Module level clock control (Inside specific peripherals)

The System Clock Generator (SCG) module is used on this device for main system clock generation. It generates clock sources like Fast IRC (FIRC, 48/52/56/60M, within 1% accuracy), Slow IRC (SIRC, 2/8M, within 3% accuracy), System Oscillator (SOSC) and LPFLL. It controls which clock source is used to derive the system clocks. The SCG also divides the selected clock source into a variety of clock domains, including the clocks for the system bus masters, system bus slaves, and flash memory.

Besides the clocks generated by SCG, there are other clock generator: OSC32, LPO from PMC.

Clock selection for most modules is controlled by the Peripheral Clock Controller (PCC) module. The PCC also implements module-specific clock gating to allow granular shutoff of modules.

Various modules have module-specific clocks that can be generated from the FIRC_CLK, SIRC_CLK, SOSC_CLK, FLL_CLK clock. In addition, there are various other module-specific clocks that have other alternate sources. While clock selection for

High-Level clocking diagram

most modules is controlled by the PCC module, some peripherals have clock source selection/divider inside the module, for details, please see the "Peripheral Clock Summary" table for more information.

17.2 High-Level clocking diagram

The following diagram shows the high-level clocking architecture and various clock sources for this device.

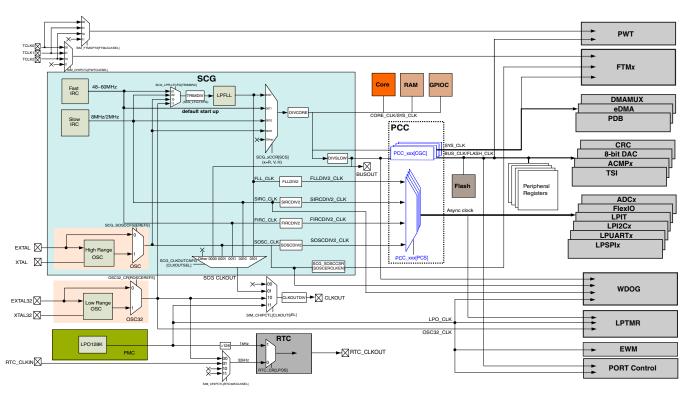


Figure 17-1. Clocking Diagram

17.3 Clock definitions

The following table describes the clocks in the previous block diagram and other sections of this document.

Clock name	Description	
CORE_CLK	Clocks the ARM core, divided by DIVCORE bits inside SCG	
SYS_CLK	Clocks the Crossbar, NVIC, Flash controller, FTM and PDB, etc. SYS_CLK can run up to CORE_CLK and divided by DIVCORE bits inside SCG.	

Table continues on the next page...

Clock name	Description		
BUS_CLK	Clocks the Peripherals, divided by DIVSLOW bits inside SCG		
FLASH_CLK	Clocks the flash module, divided by DIVSLOW bits inside SCG		
FLL_CLK	Optional divided FLL source for peripherals		
SIRC_CLK	Optional divided SIRC source for peripherals		
FIRC_CLK	Optional divided FIRC source for peripherals		
SOSC_CLK ¹	Optional divided System Oscillator clock for peripherals. NOTE: SOSC_CLK/ERCLK/OSCERCLK stands for the same clock source, in some module chapters.		
OSC32_CLK	RTC oscillator clock for RTC and peripherals		
LPO_CLK Always on low power oscillator clock inside PMC			
RTC_CLKOUT	Clock output from RTC module for both internal and external		
CLKOUT	Optional output clock source for external devices		
BUSOUT	Optional output bus clock through pin for external devices or diagnostics		

- For WDOG, its SOSC_CLK is with no dividers, and not gated by SCG_SOSCCSR[SOSCERCLKEN].
 - For FTM, its SOSC_CLK is with no dividers, but gated by SCG_SOSCCSR[SOSCERCLKEN].
 - For other peripherals (LPUART etc.), its SOSC_CLK is divided by DIVx, and not gated by SCG_SOSCCSR[SOSCERCLKEN].

17.4 Typical Clock Configuration

The clock dividers are programmed via the SCG module's clock divider registers. The following requirements must be met when configuring the clocks for this device:

The following are a few of the more common clock configurations for this device:

Clock	Normal Run (Using LPFLL)	Normal Run (Typically using FIRC)	VLPR (Using SIRC or SOSC)
CORE_CLK	72 MHz	48 MHz	4 MHz
SYS_CLK	72 MHz	48 MHz	4 MHz
BUS_CLK	24 MHz	24 MHz	1 MHz
FLASH_CLK	24 MHz	24 MHz	1 MHz

17.4.1 Default start-up clock

In default out of reset, the CPU is clocked from internal Fast IRC (IRC48M). The clocks, e.g. core clock and bus clock, are programmed via the SCG module. For the default reset value of divider, please refer to SCG chapter for details.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

17.4.2 VLPR mode clocking

The clock dividers should not be changed while in VLPR mode. They must be programmed prior to entering VLPR mode to guarantee:

- the core/system clocks are less than or equal to 4 MHz
- the flash/bus memory clocks is less than or equal to 1 MHz

17.5 Clock Gating

The clock to most of the modules can be individually gated on and off using the PCC module. After any reset, PCC disables part of the clock to the corresponding module to conserve power. Prior to initializing a module, set the corresponding clock gating control bits in PCC register to enable the clock. Before turning off the clock, make sure to disable the module.

Any bus access to a peripheral that has its bus interface clock disabled (CGC=0 in PCC module) will generate a bus fault. While any bus access to a peripheral that has its functional clock disabled (PCS=0 in PCC module) will not return a fault, but the module cannot work properly.

NOTE

Changes to clock source should be done when clock is gated by PCC to avoid glitches to output clock.

17.6 Module clocks

The following table summarizes the clocks associated with each module.

Module Name Peripheral Functional Clock Bus Interface Max Frequency of Clock **Clock Gating** Source Gated by [CGC] Clocks controlled Clocks controlled by bit of PCC by [PCS] bits of registers inside PCC ¹ module Communications LPUART0 - LPUART2 | Yes FIRC CLK, Max: 72 MHz SIRC_CLK,

Table 17-1. Peripheral Clock Summary

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Table 17-1. Peripheral Clock Summary (continued)

Module Name	Bus Interface Clock Gating	Peripheral F	unctional Clock	Max Frequency of Clock Source
	Gated by [CGC] bit of PCC	Clocks controlled by [PCS] bits of PCC ¹	Clocks controlled by registers inside module	
		FLL_CLK, SOSC_CLK		
LPSPI0 – LPSPI1	Yes	FIRC_CLK, SIRC_CLK, FLL_CLK, SOSC_CLK	-	Max: 72 MHz SCK clock Max: 25 MHz
LPI ² C0 – LPI ² C1	Yes	FIRC_CLK, SIRC_CLK, FLL_CLK, SOSC_CLK	-	Max: 60 MHz
FlexIO	Yes	FIRC_CLK, SIRC_CLK, FLL_CLK, SOSC_CLK	-	Max: 72 MHz
		Timers		
LPTMR	Yes	FIRC_CLK,	LPO_CLK,OSC32_CLK	Max: 48 MHz
		SIRC_CLK, FLL_CLK, SOSC_CLK		LPO_CLK: 128kHz
LPIT	Yes	FIRC_CLK, SIRC_CLK, FLL_CLK, SOSC_CLK	-	Max: 48 MHz
RTC	Yes	-	LPO_CLK, OSC32_CLK, RTC_CLKIN	Max: BUS_CLK LPO_CLK: 1kHz
PDB0	Yes	SYS	S_CLK	Max: SYS_CLK
FlexTimer0 - FlexTimer2	Yes	-	SYS_CLK, SOSC_CLK, TCLKx	Max: SYS_CLK
PWT	Yes	-	BUS_CLK, TCLKx	Max: BUS_CLK
		System Mod	dules	
Watchdog	No	-	BUS_CLK, SIRC_CLK, LPO_CLK, SOSC_CLK	Max: BUS_CLK LPO_CLK: 128kHz
EWM	Yes	-	LPO_CLK	LPO_CLK: 128kHz
PMC	No	-	BUS_CLK, LPO_CLK	Max: BUS_CLK
RCM	No	-	BUS_CLK, LPO_CLK	Max: BUS_CLK
				LPO_CLK: 1kHz
Port Control	Yes	-	BUS_CLK, LPO_CLK	Max: BUS_CLK
				LPO_CLK: 128kHz
SIM	No	BUS	L S_CLK	Max: BUS_CLK
CRC	Yes		 S_CLK	Max: BUS_CLK
GPIOC	No	SYS	S_CLK	Max: SYS_CLK

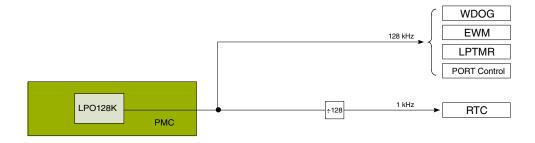
Table continues on the next page...

Table 17-1. Peripheral Clock Summary (continued)

Module Name	Bus Interface Clock Gating	Peripheral Functional Clock		Max Frequency of Clock Source	
	Gated by [CGC] bit of PCC	Clocks controlled by [PCS] bits of PCC ¹	Clocks controlled by registers inside module		
DMA	Yes	SYS	S_CLK	Max: SYS_CLK	
		Memory Mod	dules		
FTFE	Yes	FLASH_CLK		Max: FLASH_CLK	
SYS RAM	No	SYS_CLK		Max: SYS_CLK	
		Analog Mod	lules		
ADC0-ADC1	Yes	FIRC_CLK, SIRC_CLK, FLL_CLK, SOSC_CLK		Max: 50 MHz	
ACMP0-ACMP1	Yes	BUS_CLK		Max: BUS_CLK	
TSI	Yes	BUS_CLK		Max: BUS_CLK	

^{1.} The clock sources undergo clock divider DIVx in SCG (output to PCC). For details, see the "High-Level clocking diagram" section in Clocking chapter and the "Chip-specific information" section in each module chapter.

LPO clock distribution 17.6.1



17.6.2 EWM clocks

This table shows the EWM clocks and the corresponding chip clocks.

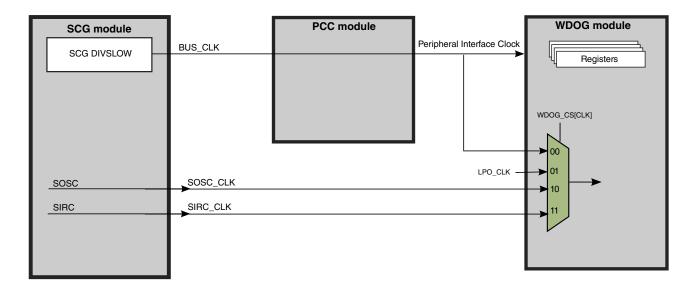
Table 17-2. EWM clock connections

Module clock	Chip clock	
Low Power Clock	128 kHz LPO Clock (LPO_CLK)	

17.6.3 WDOG Clocking Information

The following figure shows the input clock sources available for this module.

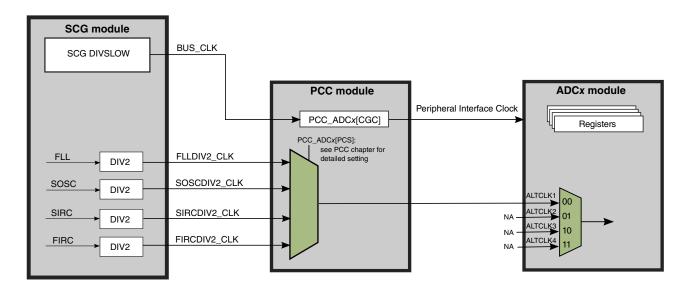
Peripheral Clocking - WDOG



17.6.4 ADC Clocking Information

The following figure shows the input clock sources available for this module.

Peripheral Clocking - ADC



Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

NOTE

ALTCLK2~4 are not connected on this chip.

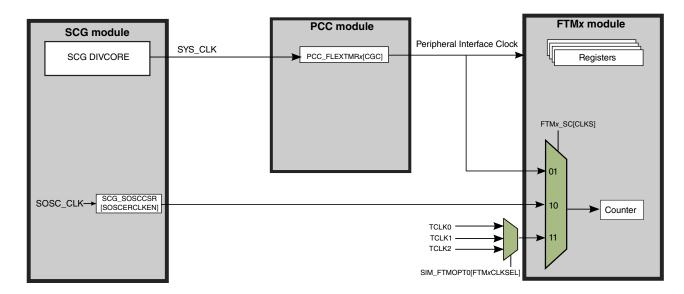
17.6.5 PDB Clock Options

The PDB module is clocked by the system clock (SYS_CLK). The SYS_CLK could run up to CPU frequency which provides higher timing resolution and more precise delay control with the PDB counter.

17.6.6 FTM Clocking Information

The following figure shows the input clock sources available for this module.

Peripheral Clocking - FTM



NOTE

Due to FTM hardware implementation limitations, the frequency of the fixed frequency clock must not exceed 1/2 of the FTM system clock frequency (SYS_CLK).

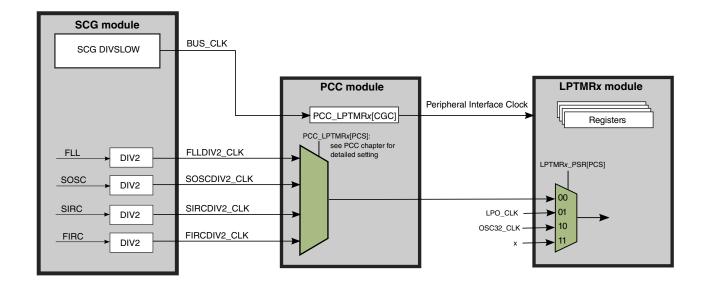
NOTE

The external clock are synchronized by FTM system clock (SYS_CLK). Therefore, to meet Nyquist criteria considering also jitter, the frequency of the external clock source must not exceed 1/4 of the system clock frequency.

17.6.7 LPTMR prescaler/glitch filter clocking options

The following figure shows the input clock sources available for this module.

Peripheral Clocking - LPTMR



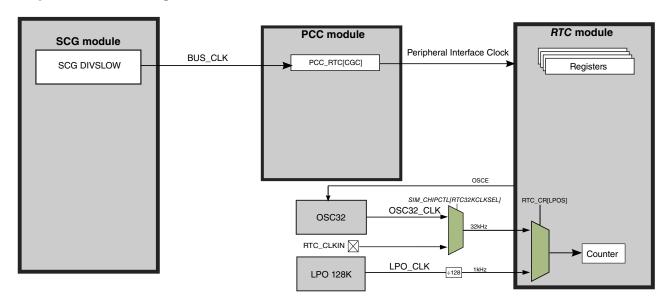
NOTE

The chosen clock must remain enabled if the LPTMR is to continue operating in all required low-power modes.

17.6.8 RTC Clocking Information

The following figure shows the input clock sources available for this module.

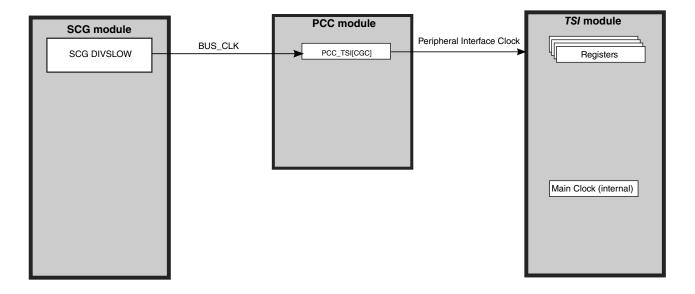
Peripheral Clocking - RTC



17.6.9 TSI Clocking Information

This following figure shows the TSI clocks.

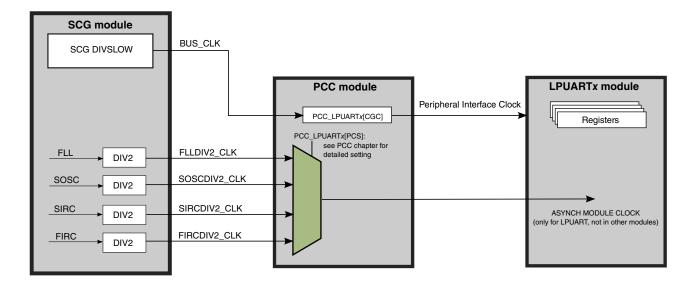
Peripheral Clocking - TSI



17.6.10 Module Clocking Information for LPUART, LPSPI, LPI2C, FlexIO and LPIT

The following figure shows the input clock sources available for this module.

Peripheral Clocking - LPUART Note: this example figure also applies similarly to the clocking for LPSPI, LPI2C, and LPIT.



Module clocks

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Chapter 18 System Clock Generator (SCG)

18.1 Chip-specific information for this module

18.1.1 Instantiation Information

18.1.1.1 Information of SCG on this device

NOTE

For the clocking dividers, DIV1 is not used on this device, and DIV2 is used in SCG for peripheral clocking. See the "High-Level clocking diagram" in the Clock Distribution chapter.

LPFLL only supports up to 72 MHz on this chip.

Writing to SCG_FIRCSTAT register can cause hard fault when auto trim is disabled.

ERCLK (External Reference Clock) is either from an external pin or from the SCG internal OSC (SOSC), and configured with the SCG_SOSCCFG[EREFS] bit.

For the supported frequency range of OSC, see the "Oscillator electrical specifications" section in the Data Sheet.

NOTE

ROSC in this chapter has the same meaning as OSC32_CLK in the Clock Distribution chapter.

18.1.1.1.1 SCG clock mode transitions

The following figure shows the valid clock mode transitions supported by SCG, for this device. For more information, see the Functional description section.

SCG Valid Mode Transitions

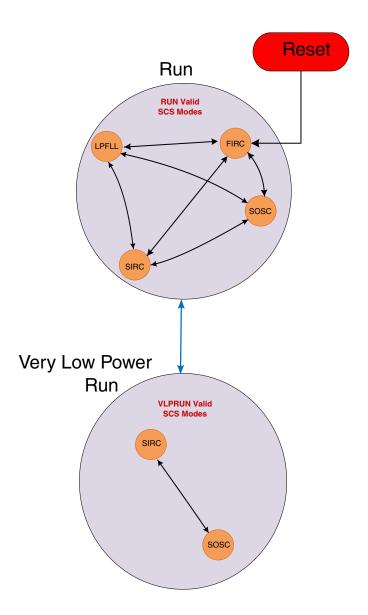


Figure 18-1. SCG Valid Mode Transition Diagram

18.1.1.1.2 Clocking configuration on SCG

The following figure shows the clocking configuration on SCG, for this device.

70 NYP Semico

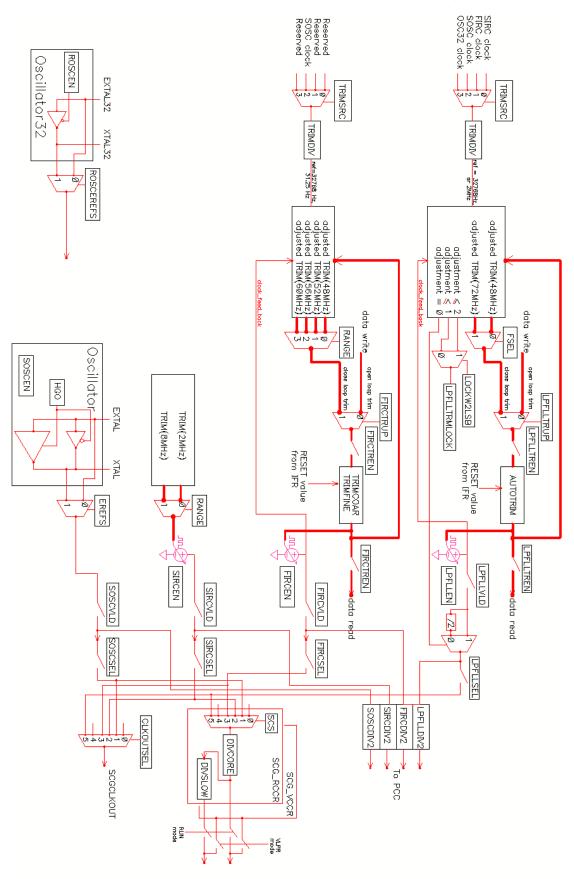


Figure 18-2. Clocking configuration on SCG

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

18.2 Introduction

The system clock generator (SCG) module provides the system clocks of the MCU. The SCG contains a frequency-locked loop (LPFLL), a slow internal reference clock (SIRC), a fast internal reference clock (FIRC), and the system oscillator clock (SOSC). The LPFLL trimming is controlled by the either the SOSC reference clock, SIRC reference clock or FIRC reference clock. The SCG can select either the output clock of the LPFLL, or a SCG reference clock (SIRC, FIRC, and SOSC) as the source for the MCU system clocks. The SCG also supports operation with crystal oscillators, which allows an external crystal, ceramic resonator, or another external clock source to produce the external reference clock (which are also available as clock sources for the MCU systems clocks).

18.2.1 **Features**

Key features of the SCG module are:

- Low Power Frequency Locked-Loop (LPFLL):
 - Programmable multiplier for up to 4 different frequency ranges
 - Internal reference clocks or oscillators reference clocks can be used as the LPFLL source for trimming purposes
 - Can be selected as the clock source for the MCU system clocks
 - 3 programmable post-divider clock outputs, which can be used as a clock source for other on-chip peripherals
- 2 Internal reference clock (IRC) generators:
 - Fast IRC clock with programmable High and Low frequency range
 - Either the slow or the fast clock can be selected as the clock source for the MCU system clocks
 - 2 programmable post-divider clock outputs for each IRC, which can be used as clock sources for other on-chip peripherals
- System Crystal Oscillator:

373

- Can be used as a source for the LPFLL
- Can be selected as the clock source for the MCU system clocks
- Clock monitor with reset and interrupt request capability for SOSC, clocks

See the Clock Distribution Chapter for more information.

18.3 Memory Map/Register Definition

This section includes the memory map and register definition.

The SCG registers can only be written when in supervisor mode. Write accesses when in user mode will result in a bus transfer error. Read accesses may be performed in both supervisor and user mode.

NOTE

For any writeable SCG registers, only 32-bit writes are allowed. 8-bit or 16-bit writes will result in transfer errors.

SCG memory map

Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page
4006_4000	Version ID Register (SCG_VERID)	32	R	0100_0000h	18.3.1/374
4006_4004	Parameter Register (SCG_PARAM)	32	R	See section	18.3.2/374
4006_4010	Clock Status Register (SCG_CSR)	32	R	See section	18.3.3/375
4006_4014	Run Clock Control Register (SCG_RCCR)	32	R/W	See section	18.3.4/377
4006_4018	VLPR Clock Control Register (SCG_VCCR)	32	R/W	See section	18.3.5/379
4006_4020	SCG CLKOUT Configuration Register (SCG_CLKOUTCNFG)	32	R/W	0300_0000h	18.3.6/381
4006_4100	System OSC Control Status Register (SCG_SOSCCSR)	32	R/W	See section	18.3.7/382
4006_4104	System OSC Divide Register (SCG_SOSCDIV)	32	R/W	0000_0000h	18.3.8/384
4006_4108	System Oscillator Configuration Register (SCG_SOSCCFG)	32	R/W	0000_0010h	18.3.9/385
4006_4200	Slow IRC Control Status Register (SCG_SIRCCSR)	32	R/W	0100_0005h	18.3.10/387
4006_4204	Slow IRC Divide Register (SCG_SIRCDIV)	32	R/W	0000_0000h	18.3.11/388
4006_4208	Slow IRC Configuration Register (SCG_SIRCCFG)	32	R/W	0000_0001h	18.3.12/389
4006_4300	Fast IRC Control Status Register (SCG_FIRCCSR)	32	R/W	See section	18.3.13/390
4006_4304	Fast IRC Divide Register (SCG_FIRCDIV)	32	R/W	0000_0000h	18.3.14/392
4006_4308	Fast IRC Configuration Register (SCG_FIRCCFG)	32	R/W	0000_0000h	18.3.15/393
4006_430C	Fast IRC Trim Configuration Register (SCG_FIRCTCFG)	32	R/W	0000_0000h	18.3.16/394
4006_4318	Fast IRC Status Register (SCG_FIRCSTAT)	32	R	See section	18.3.17/395

Table continues on the next page...

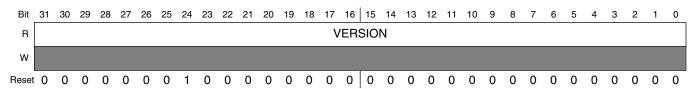
SCG memory map (continued)

Absolute address (hex)	Register name		Access	Reset value	Section/ page
4006_4500	Low Power FLL Control Status Register (SCG_LPFLLCSR)	32	R/W	0000_0000h	18.3.18/396
4006_4504	Low Power FLL Divide Register (SCG_LPFLLDIV)	32	R/W	0000_0000h	18.3.19/398
4006_4508	Low Power FLL Configuration Register (SCG_LPFLLCFG)	32	R/W	0000_0000h	18.3.20/399
4006_450C	Low Power FLL Trim Configuration Register (SCG_LPFLLTCFG)	32	R/W	0000_0000h	18.3.21/400
4006_4514	Low Power FLL Status Register (SCG_LPFLLSTAT)	32	R	See section	18.3.22/401

18.3.1 Version ID Register (SCG_VERID)

Note: Writing to this register will result in a transfer error.

Address: 4006_4000h base + 0h offset = 4006_4000h



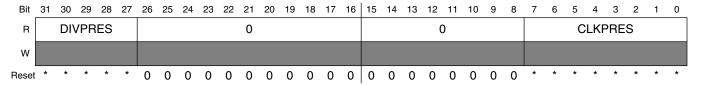
SCG_VERID field descriptions

	Field	Description
Ī	VERSION	SCG Version Number

18.3.2 Parameter Register (SCG_PARAM)

Note: Writing to this register will result in a transfer error.

Address: 4006_4000h base + 4h offset = 4006_4004h



- * Notes:
- DIVPRES field: The reset value is controlled by which SCG System Dividers are used by Soc.
- CLKPRES field: The reset value is controlled by which SCG Clock Sources are used by Soc. Please reference the Reference manual clocking chapter.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

SCG_PARAM field descriptions

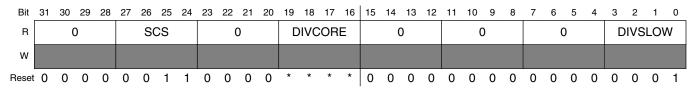
Field	Description
31–27 DIVPRES	Divider Present
	Indicates which system clock dividers are present in this instance of SCG.
	DIVPRES[27]=1 System DIVSLOW is present.
	DIVPRES[31]=1 System DIVCORE is present
26–16	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
15–8	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
CLKPRES	Clock Present
	Indicates which clock sources are present in this instance of SCG. Any bits not defined in this bit field are
	Reserved and always has the value 0 when read.
	CLKPRES[0] Reserved
	CLKPRES[1]=1System OSC (SOSC) is present
	CLKPRES[2]=1Slow IRC (SIRC) is present
	CLKPRES[3]=1Fast IRC (FIRC) is present
	CLKPRES[5]=1Low Power FLL (LPFLL) is present

18.3.3 Clock Status Register (SCG_CSR)

This register returns the currently configured system clock source and the system clock dividers for the core (DIVCORE) and peripheral interface clock (DIVSLOW). The SCG_CSR reflects the configuration set by one of three clock control registers SCG_RCCR, SCG_VCCR.

Note: Writing to this register will result in a transfer error.

Address: 4006_4000h base + 10h offset = 4006_4010h



^{*} Notes

 DIVCORE field: The reset value is controlled by user FOPT bits that get uploaded during reset. The valid reset values are div-by-1 or div-by-2 when resetting into RUN mode or div-by-4 or div-by-8 when resetting into VLPR mode.

SCG_CSR field descriptions

Field	Description	
31–28	This field is reserved.	
Reserved	This read-only field is reserved and always has the value 0.	

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Memory Map/Register Definition

SCG_CSR field descriptions (continued)

Field	Description
27–24	System Clock Source
SCS	Returns the currently configured clock source generating the system clock.
	0000 Reserved
	0001 System OSC (SOSC_CLK)
	0010 Slow IRC (SIRC_CLK)
	0011 Fast IRC (FIRC_CLK)
	0100 Reserved
	0101 Low Power FLL (LPFLL_CLK)
	0110 Reserved
	0111 Reserved
23–20	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
19-16 DIVCORE	Core Clock Divide Ratio
	0000 Divide-by-1
	0001 Divide-by-2
	0010 Divide-by-3
	0011 Divide-by-4
	0100 Divide-by-5 0101 Divide-by-6
	0101 Divide-by-6 0110 Divide-by-7
	0111 Divide-by-8
	1000 Divide-by-9
	1001 Divide-by-10
	1010 Divide-by-11
	1011 Divide-by-12
	1100 Divide-by-13
	1101 Divide-by-14
	1110 Divide-by-15
	1111 Divide-by-16
15–12	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
11–8	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
7–4 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
DIVSLOW	Slow Clock Divide Ratio
	0000 Beautiful
	0000 Reserved
	0001 Divide by 2
	0010 Divide-by-3
	0011 Divide-by-4
	0100 Divide-by-5 0101 Divide-by-6
	0110 Divide-by-7
	0111 Divide-by-8
I	TOTTI DIMOGDY-O

Table continues on the next page...

377

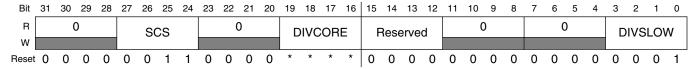
SCG_CSR field descriptions (continued)

Field		Description
	1000	Reserved
	1001	Reserved
	1010	Reserved
	1011	Reserved
	1100	Reserved
	1101	Reserved
	1110	Reserved
	1111	Reserved

18.3.4 Run Clock Control Register (SCG_RCCR)

This register controls the system clock source and the system clock dividers for the core, platform, external and bus clock domains when in Run mode only. This register can only be written using a 32-bit write. Selecting a different clock source when in RUN requires that clock source to be enabled first and be valid before system clocks switch to that clock source. If system clock divide ratios also change when selecting a different clock mode when in RUN, new system clock divide ratios will not take affect until new clock source is valid.

Address: 4006_4000h base + 14h offset = 4006_4014h



^{*} Notes:

NXP Semiconductors

SCG RCCR field descriptions

Field	Description	
31–28	This field is reserved.	
Reserved	This read-only field is reserved and always has the value 0.	
27–24 SCS	System Clock Source	
	Selects the clock source generating the system clock in Run mode. Attempting to select a clock that is no valid will be ignored. Selecting a different clock source when in Run mode requires that clock source to be enabled first and be valid before system clocks are allowed to switch to that clock source.	
	0000 Reserved	
	0001 System OSC (SOSC_CLK)	
	0010 Slow IRC (SIRC_CLK)	
	0011 Fast IRC (FIRC_CLK)	

Table continues on the next page...

DIVCORE field: The reset value is controlled by user FOPT bits that get uploaded during reset. The two valid reset values are div-by-1 and div-by-2

Memory Map/Register Definition

SCG_RCCR field descriptions (continued)

Field	Description
	0100 Reserved
	0101 Low Power FLL (LPFLL_CLK)
	0110 Reserved
	0111 Reserved
23–20	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
19-16 DIVCORE	Core Clock Divide Ratio
	0000 Divide-by-1
	0001 Divide-by-2
	0010 Divide-by-3
	0011 Divide-by-4
	0100 Divide-by-5
	0101 Divide-by-6
	0110 Divide-by-7
	0111 Divide-by-8
	1000 Divide-by-9 1001 Divide-by-10
	1010 Divide-by-10
	1011 Divide-by-12
	1100 Divide-by-13
	1101 Divide-by-14
	1110 Divide-by-15
	1111 Divide-by-16
15–12	This field is reserved. Software should write 0 to these bits to maintain compatibility.
Reserved	This field is reserved.
11–8	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
7–4	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
DIVSLOW	Slow Clock Divide Ratio
	0000 Reserved
	0001 Divide-by-2
	0010 Divide-by-3
	0011 Divide-by-4
	0100 Divide-by-5
	0101 Divide-by-6
	0110 Divide-by-7
	0111 Divide-by-8
	1000 Reserved
	1001 Reserved
	1010 Reserved
	1011 Reserved
	1100 Reserved
l	1101 Reserved

Table continues on the next page...

379

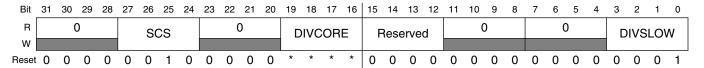
SCG_RCCR field descriptions (continued)

Field	Description
	1110 Reserved
	1111 Reserved

18.3.5 VLPR Clock Control Register (SCG_VCCR)

This register controls the system clock source and the system clock dividers for the core, platform, external and bus clock domains when in VLPR mode only. This register can only be written using a 32-bit write. Selecting a different clock source when in VLPR requires that clock source to be enabled first and be valid before system clocks switch to that clock source. If system clock divide ratios also change when selecting a different clock mode when in VLPR, new system clock divide ratios will not take affect until new clock source is valid.

Address: 4006_4000h base + 18h offset = 4006_4018h



- * Notes:
- DIVCORE field: The reset value is controlled by user FOPT bits that get uploaded during reset. The two option reset values
 are div-by-4 and div-by-8.

SCG VCCR field descriptions

Field	Description
31–28 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
27–24 SCS	System Clock Source Selects the clock source generating the system clock in VLPR mode. Attempting to select a clock that is not valid will be ignored. Selects the clock source generating the system clock. Selecting a different clock source when in VLPR mode requires that clock source to be enabled first and be valid before system clocks switch to that clock source. O000 Reserved O001 System OSC (SOSC_CLK) O010 Slow IRC (SIRC_CLK) O011 Reserved O110 Reserved O110 Reserved O111 Reserved

Table continues on the next page...

Memory Map/Register Definition

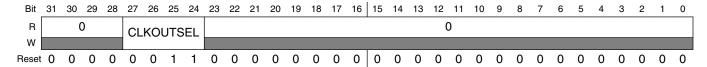
SCG_VCCR field descriptions (continued)

Field	Description
23–20	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
19–16 DIVCORE	Core Clock Divide Ratio
	0000 Divide-by-1
	0001 Divide-by-2
	0010 Divide-by-3
	0011 Divide-by-4
	0100 Divide-by-5
	0101 Divide-by-6
	0110 Divide-by-7
	0111 Divide-by-8
	1000 Divide-by-9
	1001 Divide-by-10
	1010 Divide-by-11
	1011 Divide-by-12
	1100 Divide-by-13
	1101 Divide-by-14
	1110 Divide-by-15
	1111 Divide-by-16
15–12 Reserved	This field is reserved. Software should write 0 to these bits to maintain compatibility.
	This field is reserved.
11–8 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
7–4	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
DIVSLOW	Slow Clock Divide Ratio
	0000 Reserved
	0001 Divide-by-2
	0010 Divide-by-3
	0011 Divide-by-4
	0100 Divide-by-5
	0101 Divide-by-6
	1000 Reserved
	1001 Reserved
	1010 Reserved
	1011 Reserved
	1100 Reserved
	1101 Reserved
	1110 Reserved
	I I I O Neserveu
	0110 Divide-by-7 0111 Divide-by-8 1000 Reserved 1001 Reserved 1010 Reserved 1011 Reserved 1011 Reserved 1100 Reserved

18.3.6 SCG CLKOUT Configuration Register (SCG_CLKOUTCNFG)

This register controls which SCG clock source is selected to be ported out to the CLKOUT pin.

Address: 4006_4000h base + 20h offset = 4006_4020h

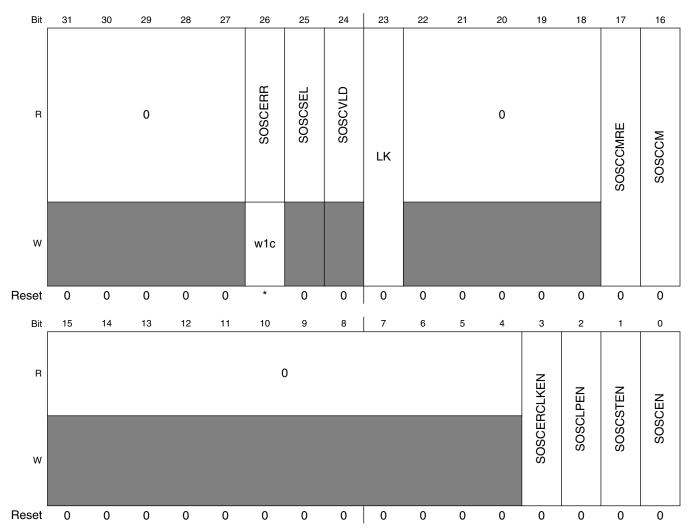


SCG_CLKOUTCNFG field descriptions

Field	Description
31–28 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
27–24 CLKOUTSEL	SCG Clkout Select
CLKOUTSEL	Selects the SCG system clock.
	0000 SCG SLOW Clock
	0001 System OSC (SOSC_CLK)
	0010 Slow IRC (SIRC_CLK)
	0011 Fast IRC (FIRC_CLK)
	0100 Reserved
	0101 Low Power FLL (LPFLL_CLK)
	0110 Reserved
	0111 Reserved
	1111 Reserved
Reserved	This field is reserved. This read-only field is reserved and always has the value 0.

18.3.7 System OSC Control Status Register (SCG_SOSCCSR)

Address: 4006_4000h base + 100h offset = 4006_4100h



^{*} Notes:

SCG_SOSCCSR field descriptions

Field	Description
31–27 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
26 SOSCERR	System OSC Clock Error This flag is reset on Chip POR only, software can also clear this flag by writing a logic one.
	 System OSC Clock Monitor is disabled or has not detected an error System OSC Clock Monitor is enabled and detected an error

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

[•] SOSCERR field: This flag is reset on Chip POR only

SCG_SOSCCSR field descriptions (continued)

Field	Description
25	System OSC Selected
SOSCSEL	System OSC is not the system clock source
	System OSC is the system clock source
24	System OSC Valid
SOSCVLD	The SOSC is considered valid after 4096 xtal counts.
	0 System OSC is not enabled or clock is not valid1 System OSC is enabled and output clock is valid
23	Lock Register
LK	
	This bit field can be cleared/set at any time.
	0 This Control Status Register can be written.
	1 This Control Status Register cannot be written.
22–18 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
17	System OSC Clock Monitor Reset Enable
SOSCCMRE	System OSC Clock Monitor Neset Enable
	O Clock Monitor generates interrupt when error detected
	1 Clock Monitor generates reset when error detected
16 SOSCCM	System OSC Clock Monitor
	Enables the clock monitor when SOSCVLD is set. If the clock source is disabled in a low power mode then the clock monitor is also disabled in the low power mode. When the clock monitor is disabled in a low power mode, it remains disabled until the clock valid flag is set following exit from the low power mode.
	0 System OSC Clock Monitor is disabled
	1 System OSC Clock Monitor is enabled
15–4	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
3 SOSCERCLKEN	System OSC 3V ERCLK Enable
SOSCENCEREN	SOSCERCLKEN is required for stop modes.
	System OSC 3V ERCLK output clock is disabled.
	System OSC 3V ERCLK output clock is enabled when SYSOSC is enabled.
2	System OSC Low Power Enable
SOSCLPEN	SOSCLPEN is required for low power modes. In VLPS mode (low power stop mode), if you want the clock to remain ON, then both SOSCLPEN and SOSCSTEN bits must be enabled.
	0 System OSC is disabled in VLP modes
	System OSC is enabled in VLP modes
1	System OSC Stop Enable
SOSCSTEN	0 System OSC is disabled in Stop modes
	System OSC is enabled in Stop modes if SOSCEN=1.
0	System OSC Enable
SOSCEN	

Table continues on the next page...

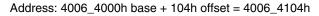
Memory Map/Register Definition

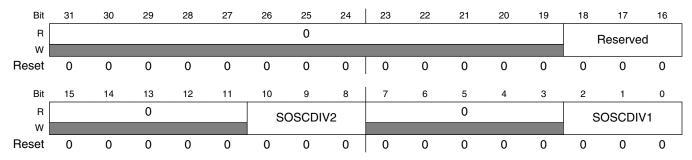
SCG_SOSCCSR field descriptions (continued)

Field	Description
	If this bit written during clock switching, it should be read back and confirmed before proceeding.
	System OSC is disabled System OSC is enabled

18.3.8 System OSC Divide Register (SCG_SOSCDIV)

The SCG_SOSCDIV register provides the control of 2 clock trees which can be used to provide optional peripheral functional clocks, or alternative module clocks. Each clock tree has optional dividers of the input SOSC clock. Changes to SOSCDIV should be done when System OSC is disabled to prevent glitches to output divided clock.





SCG_SOSCDIV field descriptions

Field	Description
31–19 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
18–16 Reserved	This field is reserved. This bit field is reserved. Software should write 0 to this bit field to maintain compatibility.
15–11 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
10–8 SOSCDIV2	System OSC Clock Divide 2 Clock divider 2 for System OSC. Used by modules that need an asynchronous clock source. 000 Output disabled 001 Divide by 1 010 Divide by 2 011 Divide by 4 100 Divide by 8 101 Divide by 16 110 Divide by 32 111 Divide by 64

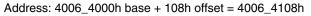
Table continues on the next page...

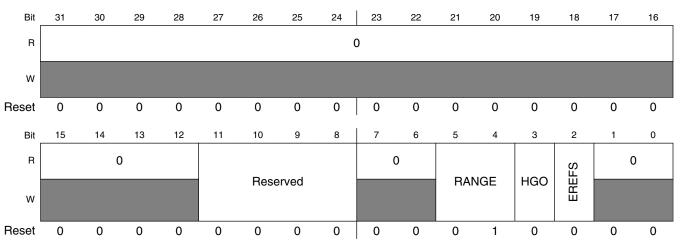
SCG_SOSCDIV field descriptions (continued)

Field	Description
7–3	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
SOSCDIV1	System OSC Clock Divide 1
	Clock divider 1 for System OSC. Used to generate the clock source for modules that need an asynchronous clock source.
	000 Output disabled
	001 Divide by 1
	010 Divide by 2
	011 Divide by 4
	100 Divide by 8
	101 Divide by 16
	110 Divide by 32
	111 Divide by 64

18.3.9 System Oscillator Configuration Register (SCG_SOSCCFG)

The SOSCCFG register cannot be changed when the System OSC is enabled. When the System OSC is enabled, writes to this register are ignored, and there is no transfer error.





SCG_SOSCCFG field descriptions

Field	Description
31–12 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
11–8 Reserved	This field is reserved. This bit is reserved. Software should write 0 to this bit field.
7–6 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.

Table continues on the next page...

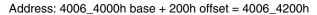
Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

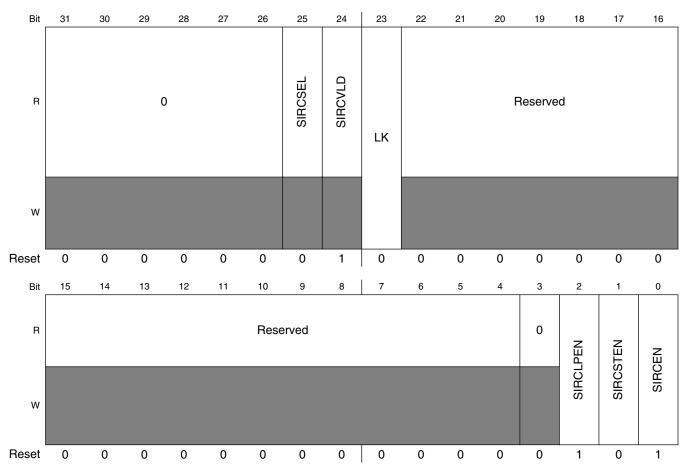
Memory Map/Register Definition

SCG_SOSCCFG field descriptions (continued)

Field	Description
5–4 RANGE	System OSC Range Select
10.1102	Selects the frequency range for the system crystal oscillator (OSC)
	See chip-specific information for supported crystal oscillator ranges.
	00 Reserved
	01 Low frequency range selected for the crystal oscillator
	10 Medium frequency range selected for the crytstal oscillator
	11 High frequency range selected for the crystal oscillator
3 HGO	High Gain Oscillator Select
	Controls the crystal oscillator power mode of operations.
	0 Configure crystal oscillator for low-gain operation
	1 Configure crystal oscillator for high-gain operation
2 EREFS	External Reference Select
	Selects the source for the external reference clock. This bit selects which clock is output from the System OSC (SOSC) into the SCG, thus either the crystal oscillator or from an external clock input
	0 External reference clock selected
	1 Internal crystal oscillator of OSC selected.
Reserved	This field is reserved.
	This read-only field is reserved and always has the value 0.

18.3.10 Slow IRC Control Status Register (SCG_SIRCCSR)





SCG_SIRCCSR field descriptions

Field	Description
31–26 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
25 SIRCSEL	Slow IRC Selected 0 Slow IRC is not the system clock source 1 Slow IRC is the system clock source
24 SIRCVLD	Slow IRC Valid O Slow IRC is not enabled or clock is not valid Slow IRC is enabled and output clock is valid
23 LK	Lock Register This bit field can be cleared/set at any time.

Table continues on the next page...

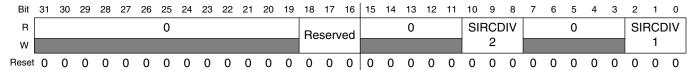
SCG_SIRCCSR field descriptions (continued)

Field	Description
	0 Control Status Register can be written.
	1 Control Status Register cannot be written.
22–4 Reserved	This field is reserved and is always has the value 0
	This field is reserved.
3 Reserved	This field is reserved and is always has the value 0
	This field is reserved.
	This read-only field is reserved and always has the value 0.
2 SIRCLPEN	Slow IRC Low Power Enable
	0 Slow IRC is disabled in VLP modes
	1 Slow IRC is enabled in VLP modes
1 SIRCSTEN	Slow IRC Stop Enable
	0 Slow IRC is disabled in supported Stop modes
	1 Slow IRC is enabled in supported Stop modes
0 SIRCEN	Slow IRC Enable
	If this bit written during clock switching, it should be read back and confirmed before proceeding.
	0 Slow IRC is disabled
	1 Slow IRC is enabled

18.3.11 Slow IRC Divide Register (SCG_SIRCDIV)

To prevent glitches to the output divided clock, change SIRDIV when the Slow IRC is disabled.

Address: 4006_4000h base + 204h offset = 4006_4204h



SCG_SIRCDIV field descriptions

Field	Description	
31–19 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.	
18–16 Reserved	This field is reserved. This bit field is reserved. Software should write 0 to this bit field to maintain compatibility.	
15–11 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.	
10–8 SIRCDIV2	Slow IRC Clock Divide 2	

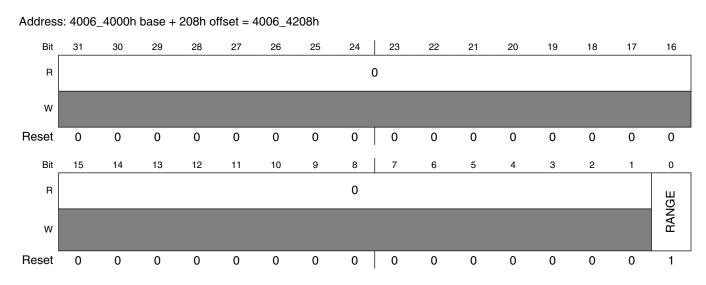
Table continues on the next page...

SCG_SIRCDIV field descriptions (continued)

Field	Description		
	Clock divider 2 for Slow IRC. Used by modules that need an asynchronous clock source.		
	000 Output disabled		
	001 Divide by 1		
	010 Divide by 2		
	011 Divide by 4		
	100 Divide by 8		
	101 Divide by 16		
	110 Divide by 32		
	111 Divide by 64		
7–3	This field is reserved.		
Reserved	This read-only field is reserved and always has the value 0.		
SIRCDIV1	Slow IRC Clock Divide 1		
	Clock divider 1 for Slow IRC. Used to generate the clock source for modules that need an asynchronous clock source.		
	000 Output disabled		
	001 Divide by 1		
	010 Divide by 2		
	011 Divide by 4		
	100 Divide by 8		
	101 Divide by 16		
	110 Divide by 32		
	111 Divide by 64		

18.3.12 Slow IRC Configuration Register (SCG_SIRCCFG)

The SIRCCFG register cannot be changed when the slow IRC clock is enabled. When the slow IRC clock is enabled, writes to this register are ignored, and there is no transfer error.



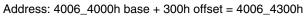
Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

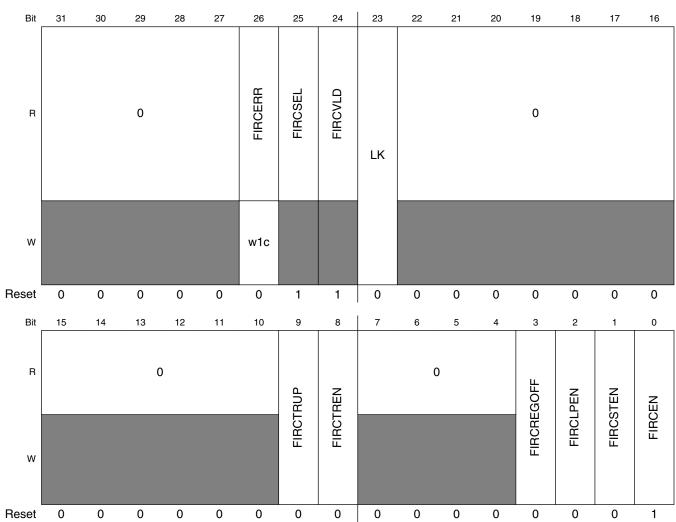
Memory Map/Register Definition

SCG_SIRCCFG field descriptions

Field	Description	
31–1 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.	
0 RANGE	Frequency Range See chip-specific information for supported frequency ranges. 0 Slow IRC low range clock (2 MHz) 1 Slow IRC high range clock (8 MHz)	

18.3.13 Fast IRC Control Status Register (SCG_FIRCCSR)





SCG_FIRCCSR field descriptions

Field	Description
31–27 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
26 FIRCERR	Fast IRC Clock Error This flag is reset on Chip POR only, software can also clear this flag by writing a logic one
	0 Error not detected with the Fast IRC trimming.
	1 Error detected with the Fast IRC trimming.
25 FIRCSEL	Fast IRC Selected status
	Fast IRC is not the system clock source Fast IRC is the system clock source
24 FIRCVLD	Fast IRC Valid status
	0 Fast IRC is not enabled or clock is not valid.
	1 Fast IRC is enabled and output clock is valid. The clock is valid once there is an output clock from the FIRC analog.
23 LK	Lock Register
	This bit field can be cleared/set at any time.
	0 Control Status Register can be written.
	1 Control Status Register cannot be written.
22–10 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
9 FIRCTRUP	Fast IRC Trim Update
	0 Disable Fast IRC trimming updates
	1 Enable Fast IRC trimming updates
8 FIRCTREN	Fast IRC Trim Enable
THISTREIT	0 Disable trimming Fast IRC to an external clock source
	1 Enable trimming Fast IRC to an external clock source
7–4 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
3 FIRCREGOFF	Fast IRC Regulator Enable
INIONEGOIP	0 Fast IRC Regulator is enabled.
	1 Fast IRC Regulator is disabled.
2 FIRCLPEN	Fast IRC Low Power Enable
	0 Fast IRC is disabled in VLP modes 1 Fast IRC is enabled in VLP modes
1	Fast IRC Stop Enable
FIRCSTEN	0 Fast IRC is disabled in Stop modes.
	1 Fast IRC is enabled in Stop modes
0	Fast IRC Enable
FIRCEN	If this bit written during clock switching, it should be read back and confirmed before proceeding.

Table continues on the next page...

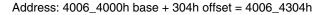
Memory Map/Register Definition

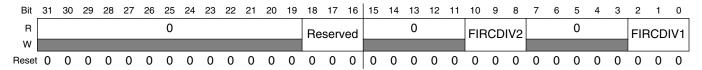
SCG_FIRCCSR field descriptions (continued)

Field	Description
	FIRCEN should not toggle when FIRCTREN = 1.
	0 Fast IRC is disabled
	1 Fast IRC is enabled

18.3.14 Fast IRC Divide Register (SCG_FIRCDIV)

Changes to FIRCDIV should be done when FAST IRC is disabled to prevent glitches to output divided clock.





SCG_FIRCDIV field descriptions

Field	Description		
31–19 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.		
18–16 Reserved	This field is reserved. This bit field is reserved. Software should write 0 to this bit field to maintain compatibility.		
15–11 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.		
10–8 FIRCDIV2	Fast IRC Clock Divide 2 Clock divider 2 for the Fast IRC. Used by modules that need an asynchronous clock source. 000 Output disabled 001 Divide by 1 010 Divide by 2 011 Divide by 4 100 Divide by 8 101 Divide by 16 110 Divide by 32 111 Divide by 64		
7–3 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.		
FIRCDIV1	Fast IRC Clock Divide 1 Clock divider 1 for Fast IRC. Used to generate the clock source for modules that need an asynchronous clock source. 000 Output disabled 001 Divide by 1		

Table continues on the next page...

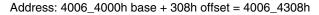
393

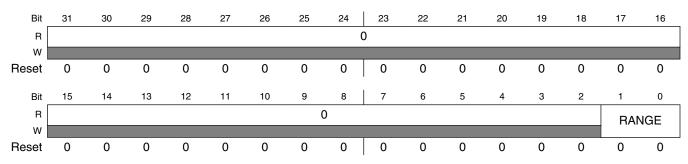
SCG_FIRCDIV field descriptions (continued)

Field		Description
	010	Divide by 2
	011	Divide by 4
	100	Divide by 8
	101	Divide by 16
	110	Divide by 32
	111	Divide by 64

18.3.15 Fast IRC Configuration Register (SCG_FIRCCFG)

The FIRCCFG register cannot be changed when the Fast IRC is enabled. When the Fast IRC is enabled, writes to this register are ignored, and there is no transfer error.



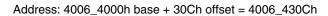


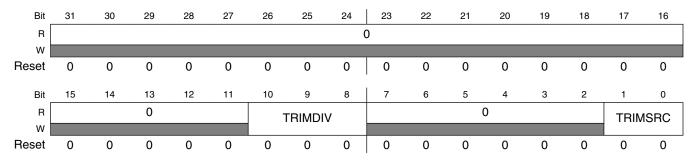
SCG_FIRCCFG field descriptions

Field	Description	
31–2 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.	
RANGE	Frequency Range See chip-specific information for supported frequency ranges. 00 Fast IRC is trimmed to 48 MHz 01 Fast IRC is trimmed to 52 MHz 10 Fast IRC is trimmed to 56 MHz	
	11 Fast IRC is trimmed to 60 MHz	

18.3.16 Fast IRC Trim Configuration Register (SCG_FIRCTCFG)

The FIRCTCFG register cannot be changed when Fast IRC tuning is enabled. When the Fast IRC tuning is enabled, writes to this register are ignored, and there is no transfer error.



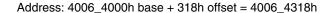


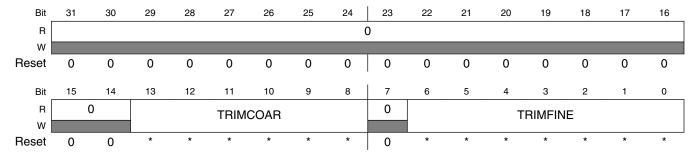
SCG_FIRCTCFG field descriptions

Field	Description		
31–16 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.		
15–11 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.		
10–8 TRIMDIV	Fast IRC Trim Predivide Divide the System OSC down for Fast IRC trimming.		
	000 Divide by 1 001 Divide by 128 010 Divide by 256 011 Divide by 512 100 Divide by 1024		
	 101 Divide by 2048 110 Reserved. Writing this value will result in Divide by 1. 111 Reserved. Writing this value will result in a Divide by 1. 		
7–2 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.		
TRIMSRC	Trim Source Configures the external clock source to tune the Fast IRC. TRMSRC must be configured before programming FIRCSTAT register for trim update 00 Reserved		
	01 Reserved 10 System OSC 11 Reserved		

18.3.17 Fast IRC Status Register (SCG_FIRCSTAT)

This register is loaded from IFR during reset. These register gets uploaded with the trim values generated by FIRC auto trimming which is enabled when FIRC is enabled and FIRCTREN=1 and FIRCTRUP=1. When FIRC auto trimming is enabled and FIRCTRUP is off (Note: TRIMSRC needs to be programmed to TRIMSRC=10 or TRIMSRC=11), writes to this register is allowed and values written to this register are used to trim FIRC clock.





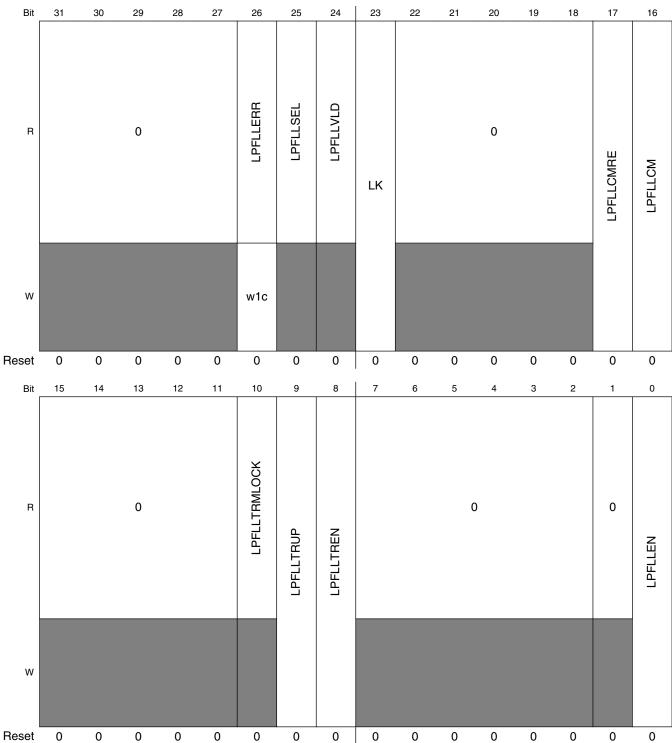
- * Notes:
- TRIMCOAR field: Reset values are loaded out of IFR.
- TRIMFINE field: Reset values are loaded out of IFR.

SCG_FIRCSTAT field descriptions

Field	Description		
31–16 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.		
15–14 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.		
13–8 TRIMCOAR	Trim Coarse TRIMCOAR bits are used to coursely trim the Fast IRC Clock to within approximately ±0.7% of the target frequency. When FIRC is enabled and auto trimming is enabled (FIRCTREN=1 and FIRCTRUP=1), then TRIMCOAR register gets uploaded with the trimmed coarse value. When FIRCTRUP=0, TRIMCOAR register is writable, to allow user programming of coarse trim values.		
7 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.		
TRIMFINE	Trim Fine Status Once the Fast IRC Clock is trimmed to ±0.7% of the target frequency using the TRIMCOAR bits, the TRIMFINE bits can be used to trim the Fast IRC Clock to within ±0.04% of the target frequency. When FIRC is enabled and auto trimming is enabled (FIRCTREN=1 and FIRCTRUP=1), TRIMFINE register gets uploaded with the trimmed fine value. When FIRCTRUP=0, TRIMFINE register is writeable, to allow user programming of fine trim values.		

18.3.18 Low Power FLL Control Status Register (SCG_LPFLLCSR)

Address: 4006_4000h base + 500h offset = 4006_4500h



SCG_LPFLLCSR field descriptions

Field	Description
31–27 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
26	LPFLL Clock Error
LPFLLERR	This flag is reset on Chip POR only, software can also clear this flag by writing a logic one
	When LPFLLTREN=1 and LPFLLTRUP=1, LPFLLERR=1 if the LPFLL can't lock the reference clock. This occurs when the reference clock is too fast/slow or LPFLL clock is stopped. LPFLLERR indicates a loss of lock or loss of clock.
	To change the reference clock frequency to re-lock, the LPFLLTREN or LPFLLTRUP bits must also be re-enabled (LPFLLTREN=1 or LPFLLTRUP=1).
	0 Error not detected with the LPFLL trimming.
	1 Error detected with the LPFLL trimming.
25 LPFLLSEL	LPFLL Selected
LITEOLL	0 LPFLL is not the system clock source
	1 LPFLL is the system clock source
24 LPFLLVLD	LPFLL Valid
	0 LPFLL is not enabled or clock is not valid.
	LPFLL is enabled and output clock is valid.
23 LK	Lock Register
	This bit field can be cleared/set at any time.
	0 Control Status Register can be written.
	1 Control Status Register cannot be written.
22–18 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
17	LPFLL Clock Monitor Reset Enable
LPFLLCMRE	Clock Monitor generates interrupt when error detected
	Clock Monitor generates reset when error detected
16 LPFLLCM	LPFLL Clock Monitor
	Enables the clock monitor when LPFLLTREN is set and LPFLL is enabled. The clock monitor is always disabled in low power modes. When the clock monitor is disabled in a low power mode, it remains disabled until the clock valid flag is set following exit from the low power mode.
	0 LPFLL Clock Monitor is disabled
	1 LPFLL Clock Monitor is enabled
15–11 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
10	LPFLL Trim LOCK
LPFLLTRMLOCK	Asserts only when LPFLLTREN=1 and LPFLLTRUP=1 and LPFLL has locked to target frequency. ¹
	0 LPFLL not Locked
	1 LPFLL trimmed and Locked

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

SCG_LPFLLCSR field descriptions (continued)

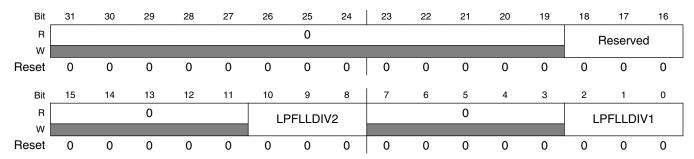
Field	Description
9 LPFLLTRUP	LPFLL Trim Update
	0 Disable LPFLL trimming updates. LPFLL frequency determined by AUTOTRIM written value.
	1 Enable LPFLL trimming updates. LPFLL frequency determined by reference clock multiplication
8 LPFLLTREN	LPFLL Trim Enable
	0 Disable trimming LPFLL to an reference clock source
	1 Enable trimming LPFLL to an reference clock source
7–2 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
1 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
0 LPFLLEN	LPFLL Enable If this bit written during clock switching, it should be read back and confirmed before proceeding.
	0 LPFLL is disabled
	1 LPFLL is enabled

^{1.} In open-loop mode (LPFLLTRUP=0), lock conditions cannot be checked.

18.3.19 Low Power FLL Divide Register (SCG_LPFLLDIV)

Changes to LPFLLDIV should be done when LPFLL is disabled to prevent glitches to output divided clock.

Address: 4006_4000h base + 504h offset = 4006_4504h



SCG_LPFLLDIV field descriptions

Field	Description
31–19 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
18–16 Reserved	This field is reserved. This bit field is reserved. Software should write 0 to this bit field to maintain compatibility.
15–11 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.

Table continues on the next page...

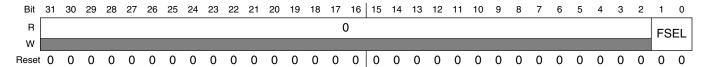
SCG_LPFLLDIV field descriptions (continued)

Field	Description	
10–8	LPFLL Clock Divide 2	
LPFLLDIV2	Clock divider 2 for the LPFLL. Used by modules that need an asynchronous clock source.	
	000 Output disabled	
	001 Divide by 1	
	010 Divide by 2	
	011 Divide by 4	
	100 Divide by 8	
	101 Divide by 16	
	110 Divide by 32	
	111 Divide by 64	
7–3	This field is reserved.	
Reserved	This read-only field is reserved and always has the value 0.	
LPFLLDIV1	LPFLL Clock Divide 1	
	Clock divider 1 for LPFLL. Used to generate the clock source for modules that need an asynchronous clock source.	
	000 Output disabled	
	001 Divide by 1	
	010 Divide by 2	
	011 Divide by 4	
	100 Divide by 8	
	101 Divide by 16	
	110 Divide by 32	
l	111 Divide by 64	

18.3.20 Low Power FLL Configuration Register (SCG_LPFLLCFG)

The LPFLLCFG register cannot be changed when the LPFLL is enabled. When the LPFLL is enabled, writes to this register are ignored, and there is no transfer error.

Address: 4006_4000h base + 508h offset = 4006_4508h



SCG_LPFLLCFG field descriptions

Field	Description
31–2 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
FSEL	Frequency Select

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

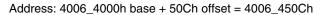
Memory Map/Register Definition

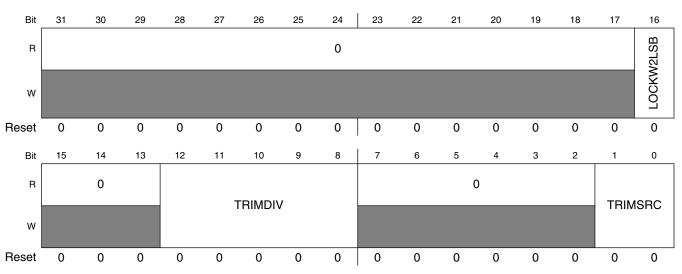
SCG_LPFLLCFG field descriptions (continued)

Field	Description
	00 LPFLL is trimmed to 48 MHz
	01 LPFLL is trimmed to 72 MHz
	Reserved
	11 Reserved

18.3.21 Low Power FLL Trim Configuration Register (SCG_LPFLLTCFG)

The LPFLLTCFG register cannot be changed when LPFLL tuning is enabled. When the LPFLL tuning is enabled, writes to this register are ignored, and there is no transfer error.





SCG_LPFLLTCFG field descriptions

Field	Description
31–17	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
16 LOCKW2LSB	Lock LPFLL with 2 LSBS
	This bitfield is used to control the condition to set LPFLLTRMLOCK: difference between LPFLL actual
	clock and target clock (48 MHz, 72 MHz) is within 0.8% or 0.4%;
	0 LPFLL locks within 1LSB (0.4%)
	1 LPFLL locks within 2LSB (0.8%)
15–13	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
12–8 TRIMDIV	LPFLL Trim Predivide

Table continues on the next page...

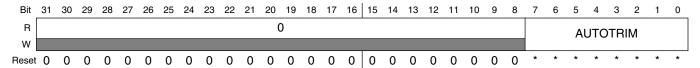
SCG_LPFLLTCFG field descriptions (continued)

Field	Description	
	Use to divide the reference clock down for LPFLL trimming by 1,2,3,431,32. The divided frequency should be either 32.768 KHz or 2 MHz.	
	00000 Divide by 1	
	00001 Divide by 2	
	00010 Divide by 3	
	11110 Divide by 31	
	11111 Divide by 32	
7–2 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.	
TRIMSRC	Trim Source	
	Configures the reference clock source to tune the LPFLL.	
	00 SIRC	
	01 FIRC	
	10 System OSC	
	11 RTC OSC	

18.3.22 Low Power FLL Status Register (SCG_LPFLLSTAT)

This register is loaded from IFR during reset. These register gets uploaded with the trim values generated by LPFLL auto trimming which is enabled when LPFLL is enabled and LPFLLTREN=1 and LPFLLTRUP=1. When LPFLL auto trimming is enabled and LPFLLTRUP is off, writes to this register is allowed and values written to this register are used to trim LPFLL clock.

Address: 4006_4000h base + 514h offset = 4006_4514h



^{*} Notes:

· AUTOTRIM field: Reset values are loaded out of IFR.

SCG_LPFLLSTAT field descriptions

Field	Description
31–8 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
AUTOTRIM	Auto Tune Trim Status

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

402

SCG_LPFLLSTAT field descriptions (continued)

Field	Description
	When LPFLL is enabled and auto trimming is enabled (LPFLLTREN=1 and LPFLLTRUP=1) these register gets uploaded with the trimmed value. When LPFLLTRUP=0, these register is writeable to allow user programming of trim values.

18.4 Functional description

18.4.1 SCG Clock Mode Transitions

The following figure shows the valid clock mode transitions supported by SCG.

Slow IRC (SIRC) boot mode is not supported on this device.

NOTE

When a transition between run modes (RUN, VLRUN) is required, the SCG should complete the switch to the clock mode as defined in the SCG clock control register first. Once the switch to the clock mode is completed, the system can then initiate the request for the selected run mode.

For example, if a transition from RUN mode to VLRUN is required, first complete any required clock change. Initiate the VLRUN request **after** the clock change has completed.

The power modes are chip specific. For more details about power mode assignments, see power management and system mode control information.

The modes of operation listed in the following table are the valid modes for this implementation of the SCG.

Table 18-1. SCG modes of operation

Mode	Description
1 -	System Oscillator Clock (SOSC) mode is entered when all the following conditions occur:
(SOSC)	RUN MODE: 0001 is written to RCCR[SCS].
	VLRUN MODE: 0001 is written to VCCR[SCS].
	• SOSCEN = 1
	• SOSCVLD = 1
	In SOSC mode, SCGCLKOUT and system clocks are derived from the external System Oscillator Clock (SOSC).

Table continues on the next page...

NXP Semiconductors

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Table 18-1. SCG modes of operation (continued)

Mode	Description
	Information regarding SOSC operation during normal and low power stop modes is found in the "Stop" row of this table.
	Slow Internal Reference Clock (SIRC) mode is entered when all the following conditions occur:
Clock (SIRC)	RUN MODE: 0010 is written to RCCR[SCS].
	VLRUN MODE: 0010 is written to VCCR[SCS] and 1 is written to SIRCCSR[SIRCLPEN].
	• SIRCEN = 1
	• SIRCVLD = 1
	In SIRC mode, SCGCLKOUT and system clocks are derived from the slow internal reference clock. Two frequency ranges are available for SIRC clock as described in the SIRCCFG[RANGE] register definition. Changes to SIRC range settings will be ignored when SIRC clock is enabled.
	Information regarding SIRC operation during normal and low power stop modes is found in the "Stop" row of this table.
Fast Internal Reference Clock (FIRC)	Fast Internal Reference Clock (FIRC) mode is the default clock mode of operation and is entered when all the following conditions occur:
	RUN MODE: 0011 is written to RCCR[SCS].
	VLRUN MODE: Invalid mode. Programming SCG into FIRC mode will be ingored.
	• FIRCEN = 1
	• FIRCVLD = 1
	In FIRC mode, SCGCLKOUT and system clocks are derived from the fast internal reference clock. Four frequency range settings are available for FIRC clock as described in the FIRC[RANGE] register definition. Changes to FIRC range settings will be ignored when FIRC clock is enabled.
	Information regarding FIRC operation during normal and low power stop modes is found in the "Stop" row of this table.
Low Power FLL	Low Power FLL (LPFLL) mode is entered when all the following conditions occur:
(LPFLL)	RUN MODE: 0101 is written to RCCR[SCS].
	VLRUN MODE: Invalid mode. Programming SCG into LPFLL mode will be ingored.
	• LPFLLEN = 1
	• LPFLLVLD = 1
	In LPFLL mode, SCGCLKOUT and system clocks are derived from the Low Power FLL (LPFLL). By default the LPFLL will be running in open-loop mode using default trim values. In closed-loop mode (LPFLLTREN=1 and LPFLLTRUP=1) LPFLL will be auto trimmed using a selectable reference clock as specified by its corresponding SCG_LPFLLTCFG[TRIMSRC]. The LPFLL will lock its frequency to the LPFLL factor, as specified by the SCG_LPFLLCFG[FSEL].
	Information regarding LPFLL operation during normal and low power stop modes is found in the "Stop" row of this table.
Stop	Entered whenever the MCU enters a Stop state. The power modes are chip specific. For power mode assignments, see the chapter that describes how modules are configured and SCG behaviour during Stop recovery. Entering Stop mode, all SCG clock signals are static except the following clocks which can continue to run and stay enabled in the following cases:
	SIRCCLK is available in Normal Stop and VLPS mode when all the following conditions become true:

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Functional description

Table 18-1. SCG modes of operation

Mode	Description
	SIRCCSR[SIRCEN] = 1
	• SIRCCSR[SIRCSTEN] = 1
	SIRCCSR[SIRCLPEN] = 1 in VLPS
	FIRCCLK is available only in Normal Stop mode when all the following conditions become true:
	• FIRCCSR[FIRCEN] = 1
	• FIRCCSR[FIRCSTEN] = 1
	SOSCLK is available in following low power stop modes (Normal Stop, VLPS) when all the below conditions are true.
	• SOSCCSR[SOSCEN] = 1
	• SOSCCSR[SOSCSTEN] = 1
	• SOSCCSR[SOSCLPEN] = 1 (required only for Low Power Stop modes (VLPS)

Chapter 19 RTC Oscillator (OSC32)

19.1 Introduction

The RTC oscillator module provides the clock source for the RTC. The RTC oscillator module, in conjunction with an external crystal, generates a reference clock for the RTC.

19.1.1 Features and Modes

The key features of the RTC oscillator are as follows:

- Supports 32 kHz crystals with very low power
- Consists of internal feed back resistor
- Automatic Gain Control (AGC) to optimize power consumption

The RTC oscillator operations are described in detail in Functional Description .

19.1.2 Block Diagram

The following is the block diagram of the RTC oscillator.

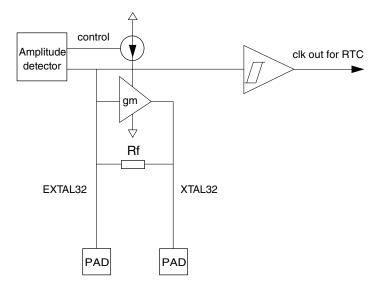


Figure 19-1. RTC Oscillator Block Diagram

19.2 RTC Signal Descriptions

The following table shows the user-accessible signals available for the RTC oscillator. See the Pinouts or Signal Multiplexing and Pin Assignment section to find out which signals are actually connected to the external pins.

Table 19-1. RTC Signal Descriptions

Signal	Description	I/O
EXTAL32	Oscillator Input	I
XTAL32	Oscillator Output	0

19.2.1 EXTAL32 — Oscillator Input

This signal is the analog input of the RTC oscillator.

19.2.2 XTAL32 — Oscillator Output

This signal is the analog output of the RTC oscillator module.

407

19.3 External Crystal Connections

The connections with a crystal is shown in the following figure. External load capacitors are required based on crystal parameters, but feedback resistor is not required.

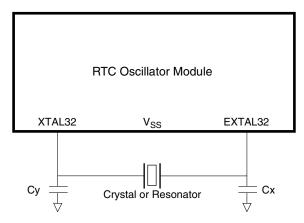


Figure 19-2. Crystal Connections

19.4 Memory Map/Register Descriptions

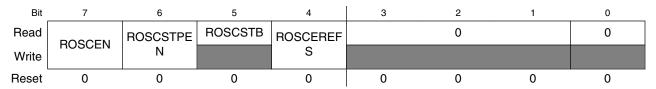
The following section shows the memory map and explains the register.

OSC32 memory map

Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page
4006_0000	RTC Oscillator Control Register (OSC32_CR)	8	R/W	00h	19.4.1/407

19.4.1 RTC Oscillator Control Register (OSC32_CR)

Address: 4006_0000h base + 0h offset = 4006_0000h



Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Functional Description

OSC32_CR field descriptions

Field	Description
7	RTC 32k Oscillator (OSC32) module enable
ROSCEN	This bit is used to enable the RTC 32k VLP Oscillator (OSC32) module.
	NOTE: It is necessary to set this bit even when the external 32k clock mode (ROSCEREFS=0) is in use.
	NOTE: If RTC_CR[OSCE] is set, this bit will be bypassed. OSC32 then works in crystal mode.
	0 OSC32 module is disabled.
	1 OSC32 module is enabled.
6 ROSCSTPEN	RTC 32k Oscillator stop mode enable
ROSCSTPEN	This bit is used to enable the RTC 32k VLP Oscillator in stop mode together with ROSCEN bitfield.
	0 Oscillator is disabled regardless the state of ROSCEN.
	1 Oscillator is enabled in Stop mode when ROSCEN is set.
5 ROSCSTB	RTC 32k Oscillator stable flag
	This flag indicates when using the crystal mode if the oscillator has started up stably after 4096 cycles.
	0 RTC 32k oscillator is unstable now and no clock will go out of the block.
	1 RTC 32k oscillator is stable.
4 ROSCEREFS	RTC 32k Oscillator external reference clcok selection
	NOTE: If RTC_CR[OSCE] is set, this bit will be bypassed. OSC32 then works in crystal mode.
	Bypass mode. RTC oscillator selects the external 32k clock. Crystal mode.
3–1 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
0 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.

Functional Description 19.5

As shown in Figure 19-1, the module includes an amplifier which supplies the negative resistor for the RTC oscillator. The gain of the amplifier is controlled by the amplitude detector, which optimizes the power consumption. A schmitt trigger is used to translate the sine-wave generated by this oscillator to a pulse clock out, which is a reference clock for the RTC digital core.

The oscillator includes an internal feedback resistor of approximately 100 M Ω between EXTAL32 and XTAL32.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018 408 **NXP Semiconductors**

19.6 Reset Overview

There is no reset state associated with the RTC oscillator.

19.7 Interrupts

The RTC oscillator does not generate any interrupts.

Interrupts

Chapter 20 Peripheral Clock Controller (PCC)

20.1 Chip-specific information for this module

20.1.1 Information of PCC on this device

The clock connection information for this module is as follows.

Clock Source : SCG	Clock Source Descriptions	PCS Clock Names of PCC
SOSCDIV2_CLK	SOSCDIV2 of system OSC clock	OSCCLK
SIRCDIV2_CLK	SIRCDIV2 of slow IRC clock	SCGIRCLK
FIRCDIV2_CLK	FIRCDIV2 of fast IRC clock	SCGFIRCLK
SFLLDIV2_CLK	FLLDIV2 of LPFLL clock	SCGFLLCLK

20.2 Introduction

The Peripheral Clock Control module (PCC) provides peripheral clock control and configuration registers.

In addition to the peripheral clock gates, clock multiplexers, and clock dividers, the PCC contains an interface between the peripherals and the system to control and acknowledge the Stop, Doze, and Debug signals.

20.2.1 Features

The PCC module enables software to configure the following clocking options for each peripheral:

Functional description

- Clock gating
- Clock source selection
- Clock divide values

The following figure is a block diagram of the PCC clock source selection and clock gating. Some peripherals also have a clock divider available. See the peripheral's PCC register for more information.

PCC - Peripheral Clock Muxing and Gating

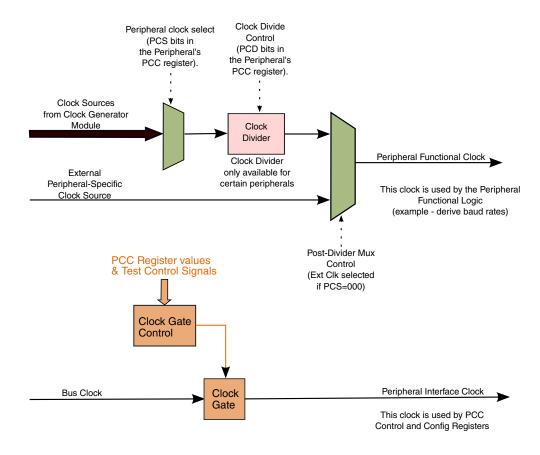


Figure 20-1. PCC Clock Source Selection and Gating

20.3 Functional description

The Peripheral Clock Control (PCC) module provides clock gating and clock source selection to each peripheral.

413

Each peripheral has its own unique PCCn register that provides clock gating for the peripheral's interface clock and its functional clock where applicable.

Optional peripheral functional clock sources can come from the SCG (xxxDIVy_CLK) or other modules such as LPO. Not all peripherals will make use of all available peripheral functional clocks.

See each peripheral's PCCn register for details.

20.4 Memory map and register definition

Each peripheral has its own dedicated PCC Register, which controls the clock gating, clock source and dividers for that specific peripheral.

NOTE

For each core processor, the number of PCC registers is different. Write accesses to unused PCC registers are blocked and result in a bus error.

20.4.1 PCC Register Descriptions

20.4.1.1 PCC Memory Map

Absolute	Register	Width	Access	Reset value
address		(In bits)		
40065020h	PCC DMA0 (PCC_DMA0)	32	RW	C0000000h
40065080h	PCC FLASH (PCC_FLASH)	32	RW	C0000000h
40065084h	PCC DMAMUX0 (PCC_DMAMUX0)	32	RW	80000000h
4006509Ch	PCC ADC1 (PCC_ADC1)	32	RW	C0000000h
400650B0h	PCC LPSPI0 (PCC_LPSPI0)	32	RW	80000000h
400650B4h	PCC LPSPI1 (PCC_LPSPI1)	32	RW	80000000h
400650C8h	PCC CRC (PCC_CRC)	32	RW	80000000h
400650D8h	PCC PDB0 (PCC_PDB0)	32	RW	80000000h
400650DCh	PCC LPIT0 (PCC_LPIT0)	32	RW	80000000h
400650E0h	PCC FLEXTMR0 (PCC_FLEXTMR0)	32	RW	80000000h
400650E4h	PCC FLEXTMR1 (PCC_FLEXTMR1)	32	RW	80000000h
400650E8h	PCC FLEXTMR2 (PCC_FLEXTMR2)	32	RW	80000000h

Table continues on the next page...

Absolute	Register	Width	Access	Reset value
address		(In bits)		
400650ECh	PCC ADC0 (PCC_ADC0)	32	RW	C0000000h
400650F4h	PCC RTC (PCC_RTC)	32	RW	80000000h
40065100h	PCC LPTMR0 (PCC_LPTMR0)	32	RW	80000000h
40065114h	PCC TSI (PCC_TSI)	32	RW	80000000h
40065124h	PCC PORTA (PCC_PORTA)	32	RW	80000000h
40065128h	PCC PORTB (PCC_PORTB)	32	RW	80000000h
4006512Ch	PCC PORTC (PCC_PORTC)	32	RW	80000000h
40065130h	PCC PORTD (PCC_PORTD)	32	RW	80000000h
40065134h	PCC PORTE (PCC_PORTE)	32	RW	80000000h
40065158h	PCC PWT (PCC_PWT)	32	RW	80000000h
40065168h	PCC FLEXIO (PCC_FLEXIO)	32	RW	80000000h
40065180h	PCC OSC32 (PCC_OSC32)	32	RW	80000000h
40065184h	PCC EWM (PCC_EWM)	32	RW	80000000h
40065198h	PCC LPI2C0 (PCC_LPI2C0)	32	RW	80000000h
4006519Ch	PCC LPI2C1 (PCC_LPI2C1)	32	RW	80000000h
400651A8h	PCC LPUART0 (PCC_LPUART0)	32	RW	80000000h
400651ACh	PCC LPUART1 (PCC_LPUART1)	32	RW	80000000h
400651B0h	PCC LPUART2 (PCC_LPUART2)	32	RW	80000000h
400651CCh	PCC CMP0 (PCC_CMP0)	32	RW	80000000h
400651D0h	PCC CMP1 (PCC_CMP1)	32	RW	80000000h

20.4.1.2 PCC DMA0 (PCC_DMA0)

20.4.1.2.1 Address

Register	Offset
PCC_DMA0	40065020h

20.4.1.2.2 Function

PCC Register

20.4.1.2.3 Diagram

Bits	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
R	PR	CGC	INUS E	Poor	erved		Poopri (o.	٨				Poor	erved			
W		CGC	_	nest	erveu		Reserve	u				nest	erveu			
Reset	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Bits	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
R				12		10			,			•	Rese	_	,	
W						Rese	erved						rved	F	Reserve	b
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

20.4.1.2.4 Fields

Field	Function
31	Enable
PR	This bit shows whether the peripheral is present on this device.
	0 - Peripheral is not present. 1 - Peripheral is present.
30	Clock Control
CGC	This read/write bit enables the clock for the peripheral.
	0 - Clock disabled 1 - Clock enabled
29	Clock Gate Control
INUSE	>This read-only bit shows that this peripheral is being used .
	0 - Peripheral is not being used.1 - Peripheral is being used. Software cannot modify the existing clocking configuration.
28-27	This read-only bit field is reserved and always has the value 0.
_	
26-24	This read-only bit field is reserved and always has the value 0.
_	
23-4	This read-only bit field is reserved and always has the value 0.
_	
3	This read-only bit field is reserved and always has the value 0.
2-0	This read-only bit field is reserved and always has the value 0.
_	

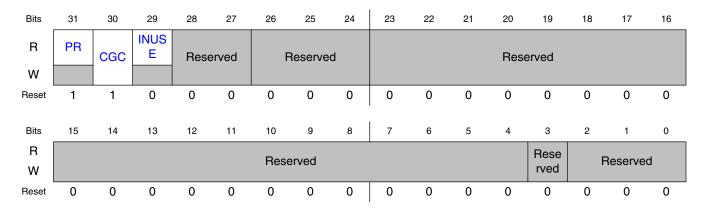
20.4.1.3 PCC FLASH (PCC_FLASH)

20.4.1.3.1 Address

Register	Offset
PCC_FLASH	40065080h

PCC Register

20.4.1.3.2 Diagram



20.4.1.3.3 Fields

Field	Function
31	Enable
PR	This bit shows whether the peripheral is present on this device.
	0 - Peripheral is not present. 1 - Peripheral is present.
30	Clock Control
CGC	This read/write bit enables the clock for the peripheral.
	0 - Clock disabled 1 - Clock enabled
29	Clock Gate Control
INUSE	>This read-only bit shows that this peripheral is being used .
	O - Peripheral is not being used. 1 - Peripheral is being used. Software cannot modify the existing clocking configuration.
28-27	This read-only bit field is reserved and always has the value 0.
_	
26-24	This read-only bit field is reserved and always has the value 0.

Table continues on the next page...

Field	Function
_	
23-4	This read-only bit field is reserved and always has the value 0.
_	
3	This read-only bit field is reserved and always has the value 0.
_	
2-0	This read-only bit field is reserved and always has the value 0.
_	

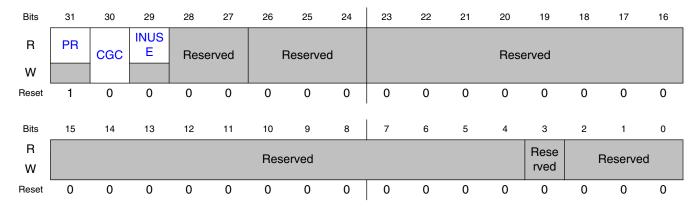
20.4.1.4 PCC DMAMUX0 (PCC_DMAMUX0)

20.4.1.4.1 Address

Register	Offset
PCC_DMAMUX0	40065084h

PCC Register

20.4.1.4.2 Diagram



20.4.1.4.3 Fields

Field	Function
31	Enable
PR	This bit shows whether the peripheral is present on this device.
	0 - Peripheral is not present.

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Field	Function
	1 - Peripheral is present.
30	Clock Control
CGC	This read/write bit enables the clock for the peripheral.
	0 - Clock disabled 1 - Clock enabled
29	Clock Gate Control
INUSE	>This read-only bit shows that this peripheral is being used .
	0 - Peripheral is not being used.1 - Peripheral is being used. Software cannot modify the existing clocking configuration.
28-27	This read-only bit field is reserved and always has the value 0.
_	
26-24	This read-only bit field is reserved and always has the value 0.
_	
23-4	This read-only bit field is reserved and always has the value 0.
_	
3	This read-only bit field is reserved and always has the value 0.
_	
2-0	This read-only bit field is reserved and always has the value 0.
_	

20.4.1.5 PCC ADC1 (PCC_ADC1)

20.4.1.5.1 Address

Register	Offset
PCC_ADC1	4006509Ch

PCC Register

419

20.4.1.5.2 Diagram

Bits	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
R	PR	CGC	INUS E	Rese	erved		PCS					Rese	erved			
W																
Reset	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Bits	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
R						Poor	erved						Rese	_	Reserve	4
W						nese	erveu						rved		nesei vei	۱
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

20.4.1.5.3 Fields

Field	Function
31	Enable
PR	This bit shows whether the peripheral is present on this device.
	0 - Peripheral is not present. 1 - Peripheral is present.
30	Clock Control
CGC	This read/write bit enables the clock for the peripheral.
	0 - Clock disabled 1 - Clock enabled
29	Clock Gate Control
INUSE	>This read-only bit shows that this peripheral is being used .
	0 - Peripheral is not being used.1 - Peripheral is being used. Software cannot modify the existing clocking configuration.
28-27	This read-only bit field is reserved and always has the value 0.
_	
26-24	Peripheral Clock Source Select
PCS	This read/write bit field is used for peripherals that support various clock selections.
	This field can only be written when the CGC bit is 0 (clock disabled). Likewise, if the INUSE flag is set, this field is locked.
	000 - Clock is off . 001 - System Oscillator Bus Clock. 010 - Slow IRC Clock. 011 - Fast IRC Clock. 100 - Reserved. 101 - Low-power FLL (LPFLL) clock. 110 - Reserved. 111 - Reserved.
23-4	This read-only bit field is reserved and always has the value 0.
_	

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Field	Function
3	This read-only bit field is reserved and always has the value 0.
_	
2-0	This read-only bit field is reserved and always has the value 0.
_	

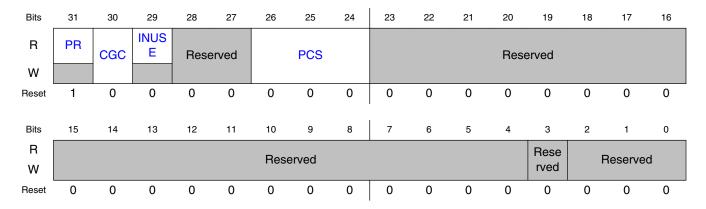
20.4.1.6 PCC LPSPI0 (PCC_LPSPI0)

20.4.1.6.1 Address

Register	Offset
PCC_LPSPI0	400650B0h

PCC Register

20.4.1.6.2 Diagram



20.4.1.6.3 Fields

Field	Function
31	Enable
PR	This bit shows whether the peripheral is present on this device.
	0 - Peripheral is not present. 1 - Peripheral is present.
30	Clock Control
CGC	This read/write bit enables the clock for the peripheral.

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Field	Function
	0 - Clock disabled 1 - Clock enabled
29	Clock Gate Control
INUSE	>This read-only bit shows that this peripheral is being used .
	0 - Peripheral is not being used.1 - Peripheral is being used. Software cannot modify the existing clocking configuration.
28-27	This read-only bit field is reserved and always has the value 0.
_	
26-24	Peripheral Clock Source Select
PCS	This read/write bit field is used for peripherals that support various clock selections.
	This field can only be written when the CGC bit is 0 (clock disabled). Likewise, if the INUSE flag is set, this field is locked.
	000 - Clock is off . 001 - System Oscillator Bus Clock. 010 - Slow IRC Clock. 011 - Fast IRC Clock. 100 - Reserved. 101 - Low-power FLL (LPFLL) clock. 110 - Reserved. 111 - Reserved.
23-4	This read-only bit field is reserved and always has the value 0.
_	
3	This read-only bit field is reserved and always has the value 0.
_	
2-0	This read-only bit field is reserved and always has the value 0.
_	

20.4.1.7 PCC LPSPI1 (PCC_LPSPI1)

20.4.1.7.1 Address

Register	Offset
PCC_LPSPI1	400650B4h

PCC Register

20.4.1.7.2 Diagram

Bits	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
R	PR	CGC	INUS E	Rese	erved		PCS					Rese	erved			
W																
Reset	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Bits	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
R						Poor	erved						Rese	_	Reserve	4
W						nese	erveu						rved	ſ	nesei vei	J
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

20.4.1.7.3 Fields

Field	Function
31	Enable
PR	This bit shows whether the peripheral is present on this device.
	0 - Peripheral is not present. 1 - Peripheral is present.
30	Clock Control
CGC	This read/write bit enables the clock for the peripheral.
	0 - Clock disabled 1 - Clock enabled
29	Clock Gate Control
INUSE	>This read-only bit shows that this peripheral is being used .
	0 - Peripheral is not being used.1 - Peripheral is being used. Software cannot modify the existing clocking configuration.
28-27	This read-only bit field is reserved and always has the value 0.
_	
26-24	Peripheral Clock Source Select
PCS	This read/write bit field is used for peripherals that support various clock selections.
	This field can only be written when the CGC bit is 0 (clock disabled). Likewise, if the INUSE flag is set, this field is locked.
	000 - Clock is off . 001 - System Oscillator Bus Clock. 010 - Slow IRC Clock. 011 - Fast IRC Clock. 100 - Reserved. 101 - Low-power FLL (LPFLL) clock. 110 - Reserved. 111 - Reserved.
23-4	This read-only bit field is reserved and always has the value 0.
_	

Table continues on the next page...

Field	Function
3	This read-only bit field is reserved and always has the value 0.
_	
2-0	This read-only bit field is reserved and always has the value 0.
_	

20.4.1.8 PCC CRC (PCC_CRC)

20.4.1.8.1 Address

Register	Offset							
PCC_CRC	400650C8h							

PCC Register

20.4.1.8.2 Diagram

Bits	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
R	PR	CGC	INUS E	Rese	erved	F	Reserve	d				Rese	erved			
W																
Reset	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
									I							
Bits	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
R						Rese	nuad						Rese		Reserve	.
W						nese	erveu						rved	r	neserved	,
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

20.4.1.8.3 Fields

Field	Function					
31	Enable					
PR	PR This bit shows whether the peripheral is present on this device.					
	0 - Peripheral is not present. 1 - Peripheral is present.					
30	Clock Control					
CGC	This read/write bit enables the clock for the peripheral.					

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Field	Function
	0 - Clock disabled
	1 - Clock enabled
29	Clock Gate Control
INUSE	>This read-only bit shows that this peripheral is being used .
	0 - Peripheral is not being used.
	1 - Peripheral is being used. Software cannot modify the existing clocking configuration.
28-27	This read-only bit field is reserved and always has the value 0.
_	
26-24	This read-only bit field is reserved and always has the value 0.
_	
23-4	This read-only bit field is reserved and always has the value 0.
_	
3	This read-only bit field is reserved and always has the value 0.
_	
2-0	This read-only bit field is reserved and always has the value 0.
_	

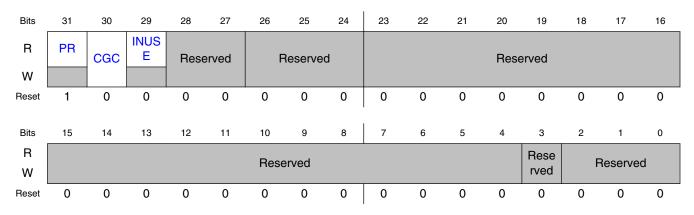
20.4.1.9 PCC PDB0 (PCC_PDB0)

20.4.1.9.1 Address

Register	Offset						
PCC_PDB0	400650D8h						

PCC Register

20.4.1.9.2 Diagram



Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

20.4.1.9.3 Fields

Field	Function
31	Enable
PR	This bit shows whether the peripheral is present on this device.
	0 - Peripheral is not present. 1 - Peripheral is present.
30	Clock Control
CGC	This read/write bit enables the clock for the peripheral.
	0 - Clock disabled 1 - Clock enabled
29	Clock Gate Control
INUSE	>This read-only bit shows that this peripheral is being used .
	0 - Peripheral is not being used.1 - Peripheral is being used. Software cannot modify the existing clocking configuration.
28-27	This read-only bit field is reserved and always has the value 0.
_	
26-24	This read-only bit field is reserved and always has the value 0.
_	
23-4	This read-only bit field is reserved and always has the value 0.
_	
3	This read-only bit field is reserved and always has the value 0.
2-0	This read-only bit field is reserved and always has the value 0.
_	

20.4.1.10 PCC LPIT0 (PCC_LPIT0)

20.4.1.10.1 Address

Register	Offset						
PCC_LPIT0	400650DCh						

PCC Register

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018 425 **NXP Semiconductors**

20.4.1.10.2 Diagram

Bits	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
R	PR	CGC	INUS E	Rese	erved		PCS					Rese	erved			
W																
Reset	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Bits	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
R						Door	an rad						Rese	_	200010	a
W						nese	erved						rved		Reserve	J
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

20.4.1.10.3 Fields

Field	Function
31	Enable
PR	This bit shows whether the peripheral is present on this device.
	0 - Peripheral is not present. 1 - Peripheral is present.
30	Clock Control
CGC	This read/write bit enables the clock for the peripheral.
	0 - Clock disabled 1 - Clock enabled
29	Clock Gate Control
INUSE	>This read-only bit shows that this peripheral is being used .
	0 - Peripheral is not being used.1 - Peripheral is being used. Software cannot modify the existing clocking configuration.
28-27	This read-only bit field is reserved and always has the value 0.
_	
26-24	Peripheral Clock Source Select
PCS	This read/write bit field is used for peripherals that support various clock selections.
	This field can only be written when the CGC bit is 0 (clock disabled). Likewise, if the INUSE flag is set, this field is locked.
	000 - Clock is off . 001 - System Oscillator Bus Clock. 010 - Slow IRC Clock. 011 - Fast IRC Clock. 100 - Reserved. 101 - Low-power FLL (LPFLL) clock. 110 - Reserved. 111 - Reserved.
23-4	This read-only bit field is reserved and always has the value 0.
_	

Table continues on the next page...

Field	Function
3	This read-only bit field is reserved and always has the value 0.
_	
2-0	This read-only bit field is reserved and always has the value 0.
_	

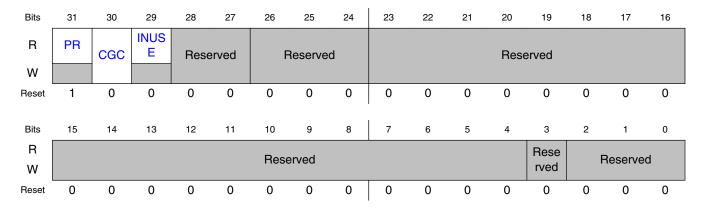
20.4.1.11 PCC FLEXTMR0 (PCC_FLEXTMR0)

20.4.1.11.1 Address

Register	Offset
PCC_FLEXTMR0	400650E0h

PCC Register

20.4.1.11.2 Diagram



20.4.1.11.3 Fields

Field	Function
31	Enable
PR	This bit shows whether the peripheral is present on this device.
	0 - Peripheral is not present. 1 - Peripheral is present.
30	Clock Control
CGC	This read/write bit enables the clock for the peripheral.

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Field	Function
	0 - Clock disabled
	1 - Clock enabled
29	Clock Gate Control
INUSE	>This read-only bit shows that this peripheral is being used .
	0 - Peripheral is not being used.
	1 - Peripheral is being used. Software cannot modify the existing clocking configuration.
28-27	This read-only bit field is reserved and always has the value 0.
_	
26-24	This read-only bit field is reserved and always has the value 0.
_	
23-4	This read-only bit field is reserved and always has the value 0.
_	
3	This read-only bit field is reserved and always has the value 0.
_	
2-0	This read-only bit field is reserved and always has the value 0.
_	

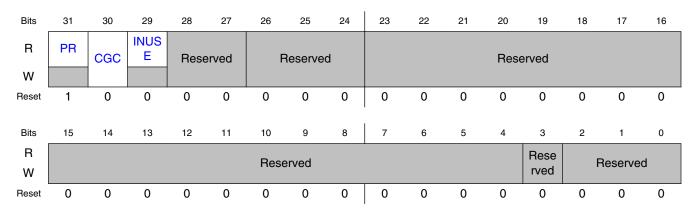
20.4.1.12 PCC FLEXTMR1 (PCC_FLEXTMR1)

20.4.1.12.1 Address

Register	Offset
PCC_FLEXTMR1	400650E4h

PCC Register

20.4.1.12.2 Diagram



Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

20.4.1.12.3 Fields

Field	Function
31	Enable
PR	This bit shows whether the peripheral is present on this device.
	0 - Peripheral is not present. 1 - Peripheral is present.
30	Clock Control
CGC	This read/write bit enables the clock for the peripheral.
	0 - Clock disabled 1 - Clock enabled
29	Clock Gate Control
INUSE	>This read-only bit shows that this peripheral is being used .
	O - Peripheral is not being used. 1 - Peripheral is being used. Software cannot modify the existing clocking configuration.
28-27	This read-only bit field is reserved and always has the value 0.
_	
26-24	This read-only bit field is reserved and always has the value 0.
_	
23-4	This read-only bit field is reserved and always has the value 0.
_	
3	This read-only bit field is reserved and always has the value 0.
2-0	This read-only bit field is reserved and always has the value 0.
_	

20.4.1.13 PCC FLEXTMR2 (PCC_FLEXTMR2)

20.4.1.13.1 Address

Register	Offset
PCC_FLEXTMR2	400650E8h

PCC Register

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018 429 **NXP Semiconductors**

20.4.1.13.2 Diagram

Bits	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
R	PR	CGC	INUS E	Rese	erved	F	Reserve	d				Rese	erved			
W				11000	,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	·	1000110	.				11000	,,,,,,			
Reset	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Bits	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
R W						Rese	erved						Rese rved	F	Reserve	b
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

20.4.1.13.3 Fields

Field	Function
31	Enable
PR	This bit shows whether the peripheral is present on this device.
	0 - Peripheral is not present. 1 - Peripheral is present.
30	Clock Control
CGC	This read/write bit enables the clock for the peripheral.
	0 - Clock disabled 1 - Clock enabled
29	Clock Gate Control
INUSE	>This read-only bit shows that this peripheral is being used .
	O - Peripheral is not being used. 1 - Peripheral is being used. Software cannot modify the existing clocking configuration.
28-27	This read-only bit field is reserved and always has the value 0.
_	
26-24	This read-only bit field is reserved and always has the value 0.
_	
23-4	This read-only bit field is reserved and always has the value 0.
_	
3	This read-only bit field is reserved and always has the value 0.
_	
2-0	This read-only bit field is reserved and always has the value 0.
_	

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018 430 **NXP Semiconductors**

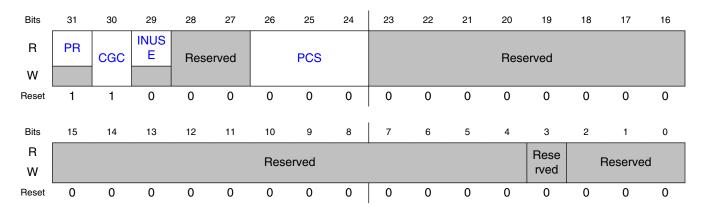
20.4.1.14 PCC ADC0 (PCC_ADC0)

20.4.1.14.1 Address

Register	Offset
PCC_ADC0	400650ECh

PCC Register

20.4.1.14.2 Diagram



20.4.1.14.3 Fields

Field	Function
31	Enable
PR	This bit shows whether the peripheral is present on this device.
	0 - Peripheral is not present. 1 - Peripheral is present.
30	Clock Control
CGC	This read/write bit enables the clock for the peripheral.
	0 - Clock disabled 1 - Clock enabled
29	Clock Gate Control
INUSE	>This read-only bit shows that this peripheral is being used .
	O - Peripheral is not being used. 1 - Peripheral is being used. Software cannot modify the existing clocking configuration.
28-27	This read-only bit field is reserved and always has the value 0.
_	
26-24	Peripheral Clock Source Select

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Field	Function
PCS	This read/write bit field is used for peripherals that support various clock selections.
	This field can only be written when the CGC bit is 0 (clock disabled). Likewise, if the INUSE flag is set, this field is locked.
	000 - Clock is off . 001 - System Oscillator Bus Clock. 010 - Slow IRC Clock. 011 - Fast IRC Clock. 100 - Reserved. 101 - Low-power FLL (LPFLL) clock. 110 - Reserved. 111 - Reserved.
23-4	This read-only bit field is reserved and always has the value 0.
_	
3	This read-only bit field is reserved and always has the value 0.
_	
2-0	This read-only bit field is reserved and always has the value 0.
_	

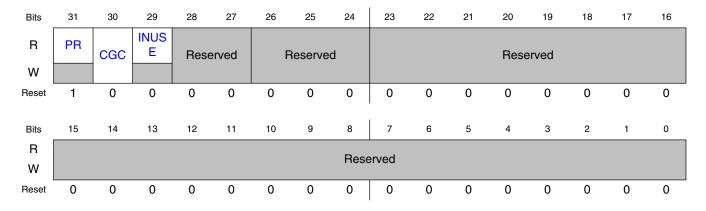
20.4.1.15 PCC RTC (PCC_RTC)

20.4.1.15.1 Address

Register	Offset
PCC_RTC	400650F4h

PCC Register

20.4.1.15.2 Diagram



20.4.1.15.3 Fields

Field	Function
31	Enable
PR	This bit shows whether the peripheral is present on this device.
	0 - Peripheral is not present. 1 - Peripheral is present.
30	Clock Control
CGC	This read/write bit enables the clock for the peripheral.
	0 - Clock disabled 1 - Clock enabled
29	Clock Gate Control
INUSE	>This read-only bit shows that this peripheral is being used .
	O - Peripheral is not being used. 1 - Peripheral is being used. Software cannot modify the existing clocking configuration.
28-27	This read-only bit field is reserved and always has the value 0.
_	
26-24	This read-only bit field is reserved and always has the value 0.
_	
23-0	This read-only bit field is reserved and always has the value 0.
_	

20.4.1.16 PCC LPTMR0 (PCC_LPTMR0)

20.4.1.16.1 Address

Register	Offset
PCC_LPTMR0	40065100h

PCC Register

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018 433 **NXP Semiconductors**

20.4.1.16.2 Diagram

Bits	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
R	PR	CGC	INUS E	Rese	erved		PCS					Rese	rved			
W																
Reset	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
									I							
Bits	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
R								Poor	erved							
W								nese	erveu							
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

20.4.1.16.3 Fields

Field	Function
31	Enable
PR	This bit shows whether the peripheral is present on this device.
	0 - Peripheral is not present. 1 - Peripheral is present.
30	Clock Control
CGC	This read/write bit enables the clock for the peripheral.
	0 - Clock disabled 1 - Clock enabled
29	Clock Gate Control
INUSE	>This read-only bit shows that this peripheral is being used .
	O - Peripheral is not being used. 1 - Peripheral is being used. Software cannot modify the existing clocking configuration.
28-27	This read-only bit field is reserved and always has the value 0.
_	
26-24	Peripheral Clock Source Select
PCS	This read/write bit field is used for peripherals that support various clock selections.
	This field can only be written when the CGC bit is 0 (clock disabled). Likewise, if the INUSE flag is set, this field is locked.
	000 - Clock is off . 001 - System Oscillator Bus Clock. 010 - Slow IRC Clock. 011 - Fast IRC Clock. 100 - Reserved. 101 - Low-power FLL (LPFLL) clock. 110 - Reserved. 111 - Reserved.
23-0	This read-only bit field is reserved and always has the value 0.
_	

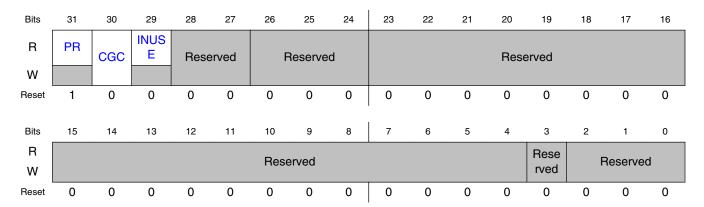
20.4.1.17 PCC TSI (PCC_TSI)

20.4.1.17.1 Address

Register	Offset
PCC_TSI	40065114h

PCC Register

20.4.1.17.2 Diagram



20.4.1.17.3 Fields

Field	Function
31	Enable
PR	This bit shows whether the peripheral is present on this device.
	0 - Peripheral is not present. 1 - Peripheral is present.
30	Clock Control
CGC	This read/write bit enables the clock for the peripheral.
	0 - Clock disabled 1 - Clock enabled
29	Clock Gate Control
INUSE	>This read-only bit shows that this peripheral is being used .
	O - Peripheral is not being used. 1 - Peripheral is being used. Software cannot modify the existing clocking configuration.
28-27	This read-only bit field is reserved and always has the value 0.

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Field	Function
_	
26-24	This read-only bit field is reserved and always has the value 0.
_	
23-4	This read-only bit field is reserved and always has the value 0.
_	
3	This read-only bit field is reserved and always has the value 0.
_	
2-0	This read-only bit field is reserved and always has the value 0.
_	

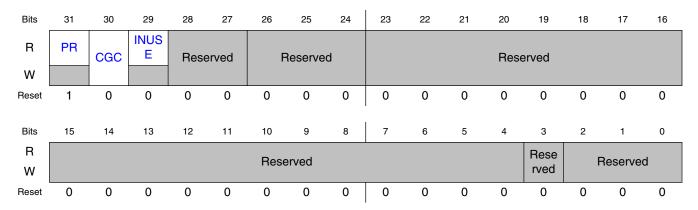
20.4.1.18 PCC PORTA (PCC_PORTA)

20.4.1.18.1 Address

Register	Offset
PCC_PORTA	40065124h

PCC Register

20.4.1.18.2 Diagram



20.4.1.18.3 Fields

Field	Function
31	Enable
PR	This bit shows whether the peripheral is present on this device.

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Field	Function
	0 - Peripheral is not present. 1 - Peripheral is present.
30	Clock Control
CGC	This read/write bit enables the clock for the peripheral.
	0 - Clock disabled 1 - Clock enabled
29	Clock Gate Control
INUSE	>This read-only bit shows that this peripheral is being used .
	0 - Peripheral is not being used.1 - Peripheral is being used. Software cannot modify the existing clocking configuration.
28-27 —	This read-only bit field is reserved and always has the value 0.
26-24	This read-only bit field is reserved and always has the value 0.
_	
23-4	This read-only bit field is reserved and always has the value 0.
_	
3	This read-only bit field is reserved and always has the value 0.
_	
2-0	This read-only bit field is reserved and always has the value 0.
_	

20.4.1.19 PCC PORTB (PCC_PORTB)

20.4.1.19.1 Address

Register	Offset
PCC_PORTB	40065128h

PCC Register

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018 437 **NXP Semiconductors**

20.4.1.19.2 Diagram

Bits	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
R	PR	CGC	INUS E	Rese	erved	F	Reserve	d				Rese	erved			
W				11000	,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	rieserved				110001100						
Reset	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Bits	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
R W						Rese	erved						Rese rved	F	Reserve	b
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

20.4.1.19.3 Fields

Field	Function
31	Enable
PR	This bit shows whether the peripheral is present on this device.
	0 - Peripheral is not present. 1 - Peripheral is present.
30	Clock Control
CGC	This read/write bit enables the clock for the peripheral.
	0 - Clock disabled 1 - Clock enabled
29	Clock Gate Control
INUSE	>This read-only bit shows that this peripheral is being used .
	O - Peripheral is not being used. 1 - Peripheral is being used. Software cannot modify the existing clocking configuration.
28-27	This read-only bit field is reserved and always has the value 0.
_	
26-24	This read-only bit field is reserved and always has the value 0.
_	
23-4	This read-only bit field is reserved and always has the value 0.
_	
3	This read-only bit field is reserved and always has the value 0.
_	
2-0	This read-only bit field is reserved and always has the value 0.
_	

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018 438 **NXP Semiconductors**

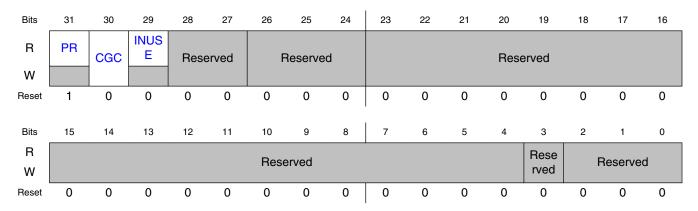
20.4.1.20 PCC PORTC (PCC_PORTC)

20.4.1.20.1 Address

Register	Offset
PCC_PORTC	4006512Ch

PCC Register

20.4.1.20.2 Diagram



20.4.1.20.3 Fields

Field	Function
31	Enable
PR	This bit shows whether the peripheral is present on this device.
	0 - Peripheral is not present. 1 - Peripheral is present.
30	Clock Control
CGC	This read/write bit enables the clock for the peripheral.
	0 - Clock disabled 1 - Clock enabled
29	Clock Gate Control
INUSE	>This read-only bit shows that this peripheral is being used .
	O - Peripheral is not being used. 1 - Peripheral is being used. Software cannot modify the existing clocking configuration.
28-27	This read-only bit field is reserved and always has the value 0.
_	
26-24	This read-only bit field is reserved and always has the value 0.

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Field	Function
_	
23-4	This read-only bit field is reserved and always has the value 0.
_	
3	This read-only bit field is reserved and always has the value 0.
_	
2-0	This read-only bit field is reserved and always has the value 0.
_	

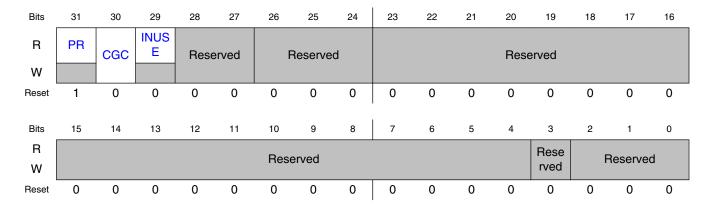
20.4.1.21 PCC PORTD (PCC_PORTD)

20.4.1.21.1 Address

Register	Offset
PCC_PORTD	40065130h

PCC Register

20.4.1.21.2 Diagram



20.4.1.21.3 Fields

Field	Function
31	Enable
PR	This bit shows whether the peripheral is present on this device.
	0 - Peripheral is not present.

Table continues on the next page...

Field	Function
	1 - Peripheral is present.
30	Clock Control
CGC	This read/write bit enables the clock for the peripheral.
	0 - Clock disabled 1 - Clock enabled
29	Clock Gate Control
INUSE	>This read-only bit shows that this peripheral is being used .
	0 - Peripheral is not being used.1 - Peripheral is being used. Software cannot modify the existing clocking configuration.
28-27	This read-only bit field is reserved and always has the value 0.
_	
26-24	This read-only bit field is reserved and always has the value 0.
_	
23-4	This read-only bit field is reserved and always has the value 0.
_	
3	This read-only bit field is reserved and always has the value 0.
_	
2-0	This read-only bit field is reserved and always has the value 0.
_	

20.4.1.22 PCC PORTE (PCC_PORTE)

20.4.1.22.1 Address

Register	Offset
PCC_PORTE	40065134h

PCC Register

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018 441 **NXP Semiconductors**

20.4.1.22.2 Diagram

Bits	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
R	PR	CGC	INUS E	Rese	erved	F	Reserve	d				Rese	erved			
W				11000	,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	·	1000110	.				11000	,,,,,,			
Reset	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Bits	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
R W						Rese	erved						Rese rved	F	Reserve	b
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

20.4.1.22.3 Fields

Field	Function
31	Enable
PR	This bit shows whether the peripheral is present on this device.
	0 - Peripheral is not present. 1 - Peripheral is present.
30	Clock Control
CGC	This read/write bit enables the clock for the peripheral.
	0 - Clock disabled 1 - Clock enabled
29	Clock Gate Control
INUSE	>This read-only bit shows that this peripheral is being used .
	O - Peripheral is not being used. 1 - Peripheral is being used. Software cannot modify the existing clocking configuration.
28-27	This read-only bit field is reserved and always has the value 0.
_	
26-24	This read-only bit field is reserved and always has the value 0.
_	
23-4	This read-only bit field is reserved and always has the value 0.
_	
3	This read-only bit field is reserved and always has the value 0.
_	
2-0	This read-only bit field is reserved and always has the value 0.
_	

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018 442 **NXP Semiconductors**

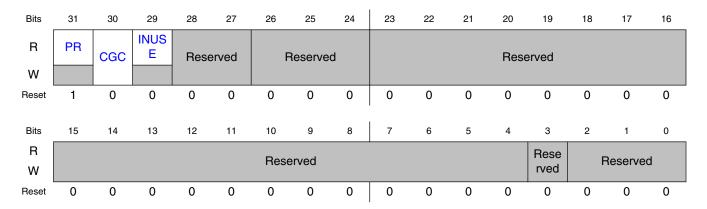
20.4.1.23 PCC PWT (PCC_PWT)

20.4.1.23.1 Address

Register	Offset
PCC_PWT	40065158h

PCC Register

20.4.1.23.2 Diagram



20.4.1.23.3 Fields

Field	Function
31	Enable
PR	This bit shows whether the peripheral is present on this device.
	0 - Peripheral is not present. 1 - Peripheral is present.
30	Clock Control
CGC	This read/write bit enables the clock for the peripheral.
	0 - Clock disabled 1 - Clock enabled
29	Clock Gate Control
INUSE	>This read-only bit shows that this peripheral is being used .
	O - Peripheral is not being used. 1 - Peripheral is being used. Software cannot modify the existing clocking configuration.
28-27	This read-only bit field is reserved and always has the value 0.
_	
26-24	This read-only bit field is reserved and always has the value 0.

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Field	Function
_	
23-4	This read-only bit field is reserved and always has the value 0.
_	
3	This read-only bit field is reserved and always has the value 0.
_	
2-0	This read-only bit field is reserved and always has the value 0.
_	

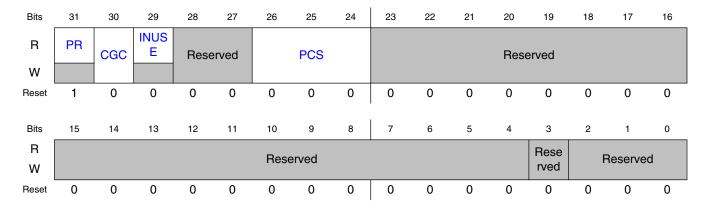
20.4.1.24 PCC FLEXIO (PCC_FLEXIO)

20.4.1.24.1 Address

Register	Offset
PCC_FLEXIO	40065168h

PCC Register

20.4.1.24.2 Diagram



20.4.1.24.3 Fields

Field	Function
31	Enable
PR	This bit shows whether the peripheral is present on this device.
	0 - Peripheral is not present.

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Field	Function
	1 - Peripheral is present.
30	Clock Control
CGC	This read/write bit enables the clock for the peripheral.
	0 - Clock disabled 1 - Clock enabled
29	Clock Gate Control
INUSE	>This read-only bit shows that this peripheral is being used .
	O - Peripheral is not being used. 1 - Peripheral is being used. Software cannot modify the existing clocking configuration.
28-27	This read-only bit field is reserved and always has the value 0.
_	
26-24	Peripheral Clock Source Select
PCS	This read/write bit field is used for peripherals that support various clock selections.
	This field can only be written when the CGC bit is 0 (clock disabled). Likewise, if the INUSE flag is set, this field is locked.
	000 - Clock is off . 001 - System Oscillator Bus Clock. 010 - Slow IRC Clock. 011 - Fast IRC Clock. 100 - Reserved. 101 - Low-power FLL (LPFLL) clock. 110 - Reserved. 111 - Reserved.
23-4	This read-only bit field is reserved and always has the value 0.
3	This read-only bit field is reserved and always has the value 0.
_	
2-0	This read-only bit field is reserved and always has the value 0.
_	

20.4.1.25 PCC OSC32 (PCC_OSC32)

20.4.1.25.1 Address

Register	Offset
PCC_OSC32	40065180h

PCC Register

20.4.1.25.2 Diagram

Bits	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
R	PR	CGC	INUS E	Rese	erved	F	Reserve	d				Rese	erved			
W				11000	,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	·	1000110	.				11000	,,,,,,			
Reset	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Bits	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
R W						Rese	erved						Rese rved	F	Reserve	b
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

20.4.1.25.3 Fields

Field	Function
31	Enable
PR	This bit shows whether the peripheral is present on this device.
	0 - Peripheral is not present. 1 - Peripheral is present.
30	Clock Control
CGC	This read/write bit enables the clock for the peripheral.
	0 - Clock disabled 1 - Clock enabled
29	Clock Gate Control
INUSE	>This read-only bit shows that this peripheral is being used .
	0 - Peripheral is not being used.1 - Peripheral is being used. Software cannot modify the existing clocking configuration.
28-27	This read-only bit field is reserved and always has the value 0.
_	
26-24	This read-only bit field is reserved and always has the value 0.
_	
23-4	This read-only bit field is reserved and always has the value 0.
_	
3	This read-only bit field is reserved and always has the value 0.
_	
2-0	This read-only bit field is reserved and always has the value 0.
_	

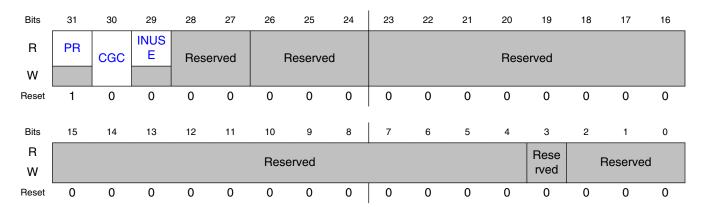
20.4.1.26 PCC EWM (PCC_EWM)

20.4.1.26.1 Address

Register	Offset
PCC_EWM	40065184h

PCC Register

20.4.1.26.2 Diagram



20.4.1.26.3 Fields

Field	Function
31	Enable
PR	This bit shows whether the peripheral is present on this device.
	0 - Peripheral is not present. 1 - Peripheral is present.
30	Clock Control
CGC	This read/write bit enables the clock for the peripheral.
	0 - Clock disabled 1 - Clock enabled
29	Clock Gate Control
INUSE	>This read-only bit shows that this peripheral is being used .
	0 - Peripheral is not being used.1 - Peripheral is being used. Software cannot modify the existing clocking configuration.
28-27	This read-only bit field is reserved and always has the value 0.
_	
26-24	This read-only bit field is reserved and always has the value 0.

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Field	Function
_	
23-4	This read-only bit field is reserved and always has the value 0.
_	
3	This read-only bit field is reserved and always has the value 0.
_	
2-0	This read-only bit field is reserved and always has the value 0.
_	

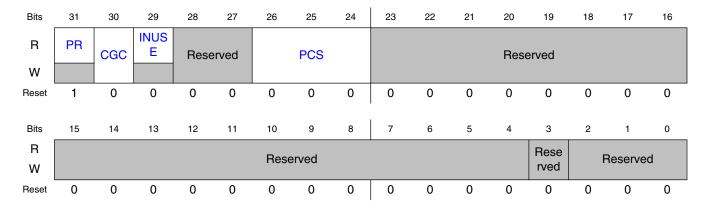
20.4.1.27 PCC LPI2C0 (PCC_LPI2C0)

20.4.1.27.1 Address

Register	Offset
PCC_LPI2C0	40065198h

PCC Register

20.4.1.27.2 Diagram



20.4.1.27.3 Fields

Field	Function
31	Enable
PR	This bit shows whether the peripheral is present on this device.
	0 - Peripheral is not present.

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Field	Function
	1 - Peripheral is present.
30	Clock Control
CGC	This read/write bit enables the clock for the peripheral.
	0 - Clock disabled 1 - Clock enabled
29	Clock Gate Control
INUSE	>This read-only bit shows that this peripheral is being used .
	O - Peripheral is not being used. 1 - Peripheral is being used. Software cannot modify the existing clocking configuration.
28-27	This read-only bit field is reserved and always has the value 0.
_	
26-24	Peripheral Clock Source Select
PCS	This read/write bit field is used for peripherals that support various clock selections.
	This field can only be written when the CGC bit is 0 (clock disabled). Likewise, if the INUSE flag is set, this field is locked.
	000 - Clock is off . 001 - System Oscillator Bus Clock. 010 - Slow IRC Clock. 011 - Fast IRC Clock. 100 - Reserved. 101 - Low-power FLL (LPFLL) clock. 110 - Reserved. 111 - Reserved.
23-4	This read-only bit field is reserved and always has the value 0.
_	
3	This read-only bit field is reserved and always has the value 0.
_	
2-0	This read-only bit field is reserved and always has the value 0.
_	

20.4.1.28 PCC LPI2C1 (PCC_LPI2C1)

20.4.1.28.1 Address

Register	Offset
PCC_LPI2C1	4006519Ch

PCC Register

20.4.1.28.2 Diagram

Bits	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
R	PR	CGC	INUS E	Rese	erved		PCS					Rese	erved			
W																
Reset	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Bits	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
R						Door	an rad						Rese	_	200010	a
W						nese	erved						rved		Reserve	J
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

20.4.1.28.3 Fields

Sample This bit shows whether the peripheral is present on this device.	
0 - Peripheral is not present. 1 - Peripheral is present. 30 Clock Control CGC This read/write bit enables the clock for the peripheral. 0 - Clock disabled 1 - Clock enabled 29 Clock Gate Control INUSE >This read-only bit shows that this peripheral is being used . 0 - Peripheral is not being used. 1 - Peripheral is being used. 1 - Peripheral is being used. Software cannot modify the existing clocking configuration. 28-27 This read-only bit field is reserved and always has the value 0. 26-24 Peripheral Clock Source Select PCS This read/write bit field is used for peripherals that support various clock selections. This field can only be written when the CGC bit is 0 (clock disabled). Likewise, if the INUSE flag this field is locked. 000 - Clock is off . 001 - System Oscillator Bus Clock. 010 - Slow IRC Clock. 011 - Fast IRC Clock.	
1 - Peripheral is present. 30 Clock Control CGC This read/write bit enables the clock for the peripheral. 0 - Clock disabled 1 - Clock enabled 29 Clock Gate Control INUSE >This read-only bit shows that this peripheral is being used . 0 - Peripheral is not being used. 1 - Peripheral is being used. 28-27 This read-only bit field is reserved and always has the value 0. 28-27 Peripheral Clock Source Select PCS This read/write bit field is used for peripherals that support various clock selections. This field can only be written when the CGC bit is 0 (clock disabled). Likewise, if the INUSE flag this field is locked. 000 - Clock is off . 001 - System Oscillator Bus Clock. 010 - Slow IRC Clock. 011 - Fast IRC Clock.	
CGC This read/write bit enables the clock for the peripheral. 0 - Clock disabled 1 - Clock enabled 29 Clock Gate Control INUSE >This read-only bit shows that this peripheral is being used . 0 - Peripheral is not being used. 1 - Peripheral is being used. Software cannot modify the existing clocking configuration. 28-27 This read-only bit field is reserved and always has the value 0. 26-24 PCS Peripheral Clock Source Select This read/write bit field is used for peripherals that support various clock selections. This field can only be written when the CGC bit is 0 (clock disabled). Likewise, if the INUSE flag this field is locked. 000 - Clock is off . 001 - System Oscillator Bus Clock. 010 - Slow IRC Clock. 011 - Fast IRC Clock.	
0 - Clock disabled 1 - Clock enabled 29	
1 - Clock enabled 29 Clock Gate Control INUSE >This read-only bit shows that this peripheral is being used . 0 - Peripheral is not being used. 1 - Peripheral is being used. Software cannot modify the existing clocking configuration. 28-27 This read-only bit field is reserved and always has the value 0. 26-24 Peripheral Clock Source Select PCS This read/write bit field is used for peripherals that support various clock selections. This field can only be written when the CGC bit is 0 (clock disabled). Likewise, if the INUSE flag this field is locked. 000 - Clock is off . 001 - System Oscillator Bus Clock. 010 - Slow IRC Clock. 011 - Fast IRC Clock.	
INUSE >This read-only bit shows that this peripheral is being used . 0 - Peripheral is not being used. 1 - Peripheral is being used. Software cannot modify the existing clocking configuration. 28-27 This read-only bit field is reserved and always has the value 0. 26-24 Peripheral Clock Source Select PCS This read/write bit field is used for peripherals that support various clock selections. This field can only be written when the CGC bit is 0 (clock disabled). Likewise, if the INUSE flag this field is locked. 000 - Clock is off . 001 - System Oscillator Bus Clock. 010 - Slow IRC Clock. 011 - Fast IRC Clock.	
0 - Peripheral is not being used. 1 - Peripheral is being used. Software cannot modify the existing clocking configuration. 28-27 This read-only bit field is reserved and always has the value 0. — 26-24 Peripheral Clock Source Select PCS This read/write bit field is used for peripherals that support various clock selections. This field can only be written when the CGC bit is 0 (clock disabled). Likewise, if the INUSE flag this field is locked. 000 - Clock is off . 001 - System Oscillator Bus Clock. 010 - Slow IRC Clock. 011 - Fast IRC Clock.	
1 - Peripheral is being used. Software cannot modify the existing clocking configuration. 28-27 This read-only bit field is reserved and always has the value 0. — 26-24 Peripheral Clock Source Select PCS This read/write bit field is used for peripherals that support various clock selections. This field can only be written when the CGC bit is 0 (clock disabled). Likewise, if the INUSE flag this field is locked. 000 - Clock is off . 001 - System Oscillator Bus Clock. 010 - Slow IRC Clock. 011 - Fast IRC Clock.	
Peripheral Clock Source Select PCS This read/write bit field is used for peripherals that support various clock selections. This field can only be written when the CGC bit is 0 (clock disabled). Likewise, if the INUSE flag this field is locked. 000 - Clock is off . 001 - System Oscillator Bus Clock. 010 - Slow IRC Clock. 011 - Fast IRC Clock.	
PCS This read/write bit field is used for peripherals that support various clock selections. This field can only be written when the CGC bit is 0 (clock disabled). Likewise, if the INUSE flag this field is locked. 000 - Clock is off . 001 - System Oscillator Bus Clock. 010 - Slow IRC Clock. 011 - Fast IRC Clock.	
PCS This read/write bit field is used for peripherals that support various clock selections. This field can only be written when the CGC bit is 0 (clock disabled). Likewise, if the INUSE flag this field is locked. 000 - Clock is off . 001 - System Oscillator Bus Clock. 010 - Slow IRC Clock. 011 - Fast IRC Clock.	
This field can only be written when the CGC bit is 0 (clock disabled). Likewise, if the INUSE flag this field is locked. 000 - Clock is off . 001 - System Oscillator Bus Clock. 010 - Slow IRC Clock. 011 - Fast IRC Clock.	
this field is locked. 000 - Clock is off . 001 - System Oscillator Bus Clock. 010 - Slow IRC Clock. 011 - Fast IRC Clock.	
001 - System Oscillator Bus Clock. 010 - Slow IRC Clock. 011 - Fast IRC Clock.	is set,
100 - Reserved. 101 - Low-power FLL (LPFLL) clock. 110 - Reserved. 111 - Reserved.	
This read-only bit field is reserved and always has the value 0.	
_	

Table continues on the next page...

Field	Function
3	This read-only bit field is reserved and always has the value 0.
_	
2-0	This read-only bit field is reserved and always has the value 0.
_	

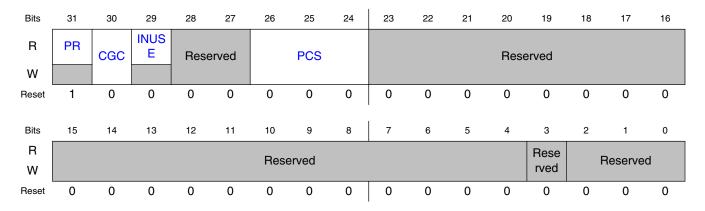
20.4.1.29 PCC LPUARTO (PCC_LPUARTO)

20.4.1.29.1 Address

Register	Offset
PCC_LPUART0	400651A8h

PCC Register

20.4.1.29.2 Diagram



20.4.1.29.3 Fields

Field	Function						
31	Enable						
PR	This bit shows whether the peripheral is present on this device.						
	0 - Peripheral is not present. 1 - Peripheral is present.						
30	Clock Control						
CGC	This read/write bit enables the clock for the peripheral.						

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Field	Function
	0 - Clock disabled 1 - Clock enabled
29	Clock Gate Control
INUSE	>This read-only bit shows that this peripheral is being used .
	O - Peripheral is not being used. 1 - Peripheral is being used. Software cannot modify the existing clocking configuration.
28-27	This read-only bit field is reserved and always has the value 0.
_	
26-24	Peripheral Clock Source Select
PCS	This read/write bit field is used for peripherals that support various clock selections.
	This field can only be written when the CGC bit is 0 (clock disabled). Likewise, if the INUSE flag is set, this field is locked.
	000 - Clock is off . 001 - System Oscillator Bus Clock. 010 - Slow IRC Clock. 011 - Fast IRC Clock. 100 - Reserved. 101 - Low-power FLL (LPFLL) clock. 110 - Reserved. 111 - Reserved.
23-4	This read-only bit field is reserved and always has the value 0.
_	
3	This read-only bit field is reserved and always has the value 0.
_	
2-0 —	This read-only bit field is reserved and always has the value 0.

20.4.1.30 PCC LPUART1 (PCC_LPUART1)

20.4.1.30.1 Address

Register	Offset
PCC_LPUART1	400651ACh

PCC Register

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018 452 **NXP Semiconductors**

20.4.1.30.2 Diagram

Bits	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
R	PR	CGC	INUS E	Rese	erved		PCS					Rese	erved			
W																
Reset	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Bits	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
R						Door	an rad						Rese	_	200010	a
W						nese	erved						rved		Reserve	J
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

20.4.1.30.3 Fields

Field	Function
31	Enable
PR	This bit shows whether the peripheral is present on this device.
	0 - Peripheral is not present. 1 - Peripheral is present.
30	Clock Control
CGC	This read/write bit enables the clock for the peripheral.
	0 - Clock disabled 1 - Clock enabled
29	Clock Gate Control
INUSE	>This read-only bit shows that this peripheral is being used .
	0 - Peripheral is not being used.1 - Peripheral is being used. Software cannot modify the existing clocking configuration.
28-27	This read-only bit field is reserved and always has the value 0.
_	
26-24	Peripheral Clock Source Select
PCS	This read/write bit field is used for peripherals that support various clock selections.
	This field can only be written when the CGC bit is 0 (clock disabled). Likewise, if the INUSE flag is set, this field is locked.
	000 - Clock is off . 001 - System Oscillator Bus Clock. 010 - Slow IRC Clock. 011 - Fast IRC Clock. 100 - Reserved. 101 - Low-power FLL (LPFLL) clock. 110 - Reserved. 111 - Reserved.
23-4	This read-only bit field is reserved and always has the value 0.
_	

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Field	Function
3	This read-only bit field is reserved and always has the value 0.
_	
2-0	This read-only bit field is reserved and always has the value 0.
_	

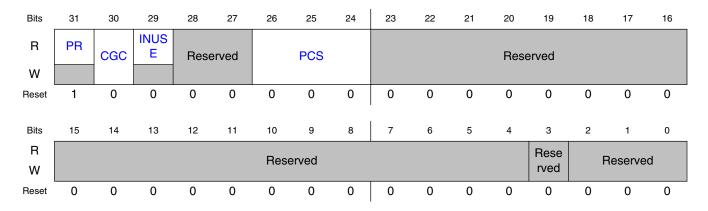
20.4.1.31 PCC LPUART2 (PCC_LPUART2)

20.4.1.31.1 Address

Register	Offset			
PCC_LPUART2	400651B0h			

PCC Register

20.4.1.31.2 Diagram



20.4.1.31.3 Fields

Field	Function	
31	Enable	
PR	This bit shows whether the peripheral is present on this device.	
	0 - Peripheral is not present. 1 - Peripheral is present.	
30	Clock Control	
CGC	This read/write bit enables the clock for the peripheral.	

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Field	Function
	0 - Clock disabled 1 - Clock enabled
29	Clock Gate Control
INUSE	>This read-only bit shows that this peripheral is being used .
	O - Peripheral is not being used. 1 - Peripheral is being used. Software cannot modify the existing clocking configuration.
28-27	This read-only bit field is reserved and always has the value 0.
_	
26-24	Peripheral Clock Source Select
PCS	This read/write bit field is used for peripherals that support various clock selections.
	This field can only be written when the CGC bit is 0 (clock disabled). Likewise, if the INUSE flag is set, this field is locked.
	000 - Clock is off . 001 - System Oscillator Bus Clock. 010 - Slow IRC Clock. 011 - Fast IRC Clock. 100 - Reserved. 101 - Low-power FLL (LPFLL) clock. 110 - Reserved. 111 - Reserved.
23-4	This read-only bit field is reserved and always has the value 0.
_	
3	This read-only bit field is reserved and always has the value 0.
_	
2-0	This read-only bit field is reserved and always has the value 0.
_	

20.4.1.32 PCC CMP0 (PCC_CMP0)

20.4.1.32.1 Address

Register	Offset
PCC_CMP0	400651CCh

PCC Register

20.4.1.32.2 Diagram

Bits	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
R	PR	CGC	INUS E	Rese	erved	F	Reserve	d				Rese	erved			
W				Reserved		rieserved			Tieserveu							
Reset	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Bits	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
R W						Rese	erved						Rese rved	F	Reserve	b
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

20.4.1.32.3 Fields

Field	Function
31	Enable
PR	This bit shows whether the peripheral is present on this device.
	0 - Peripheral is not present. 1 - Peripheral is present.
30	Clock Control
CGC	This read/write bit enables the clock for the peripheral.
	0 - Clock disabled 1 - Clock enabled
29	Clock Gate Control
INUSE	>This read-only bit shows that this peripheral is being used .
	0 - Peripheral is not being used.1 - Peripheral is being used. Software cannot modify the existing clocking configuration.
28-27	This read-only bit field is reserved and always has the value 0.
_	
26-24	This read-only bit field is reserved and always has the value 0.
_	
23-4	This read-only bit field is reserved and always has the value 0.
_	
3	This read-only bit field is reserved and always has the value 0.
_	
2-0	This read-only bit field is reserved and always has the value 0.
_	

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018 456 **NXP Semiconductors**

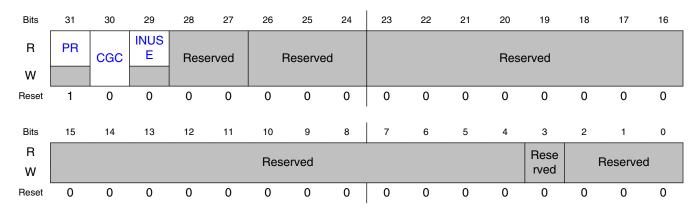
20.4.1.33 PCC CMP1 (PCC_CMP1)

20.4.1.33.1 Address

Register	Offset
PCC_CMP1	400651D0h

PCC Register

20.4.1.33.2 Diagram



20.4.1.33.3 Fields

Field	Function
31	Enable
PR	This bit shows whether the peripheral is present on this device.
	0 - Peripheral is not present. 1 - Peripheral is present.
30	Clock Control
CGC	This read/write bit enables the clock for the peripheral.
	0 - Clock disabled 1 - Clock enabled
29	Clock Gate Control
INUSE	>This read-only bit shows that this peripheral is being used .
	O - Peripheral is not being used. 1 - Peripheral is being used. Software cannot modify the existing clocking configuration.
28-27	This read-only bit field is reserved and always has the value 0.
_	
26-24	This read-only bit field is reserved and always has the value 0.

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Field	Function
_	
23-4	This read-only bit field is reserved and always has the value 0.
_	
3	This read-only bit field is reserved and always has the value 0.
_	
2-0	This read-only bit field is reserved and always has the value 0.
_	

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Chapter 21 Reset and Boot

21.1 Introduction

The following reset sources are supported in this MCU:

Table 21-1. Reset sources

Reset sources	Description
POR reset	Power-on reset (POR)
System resets	External pin reset (PIN) Low voltage detect (LVD) Software watchdog reset (WDOG) Clock generator loss of clock (LOC) reset Clock generator loss of lock (LOL) reset Stop mode acknowledge error (SACKERR) Software reset (SW) Lockup reset (LOCKUP) MDM DAP system reset
Debug reset	Debug reset

Each of the reset sources has an associated bit in the system reset status (RCM_SRS) register. Besides immediate reset, the RCM module also supports optional delays of the system resets for a period of time with an interrupt generated. This provides software an option to perform a graceful shutdown. See the Reset Control Module (RCM) chapter for register details.

The MCU exits reset in functional mode where the CPU is executing code. See Boot options for more details.

The following figure shows a block diagram of the reset sources for this device.

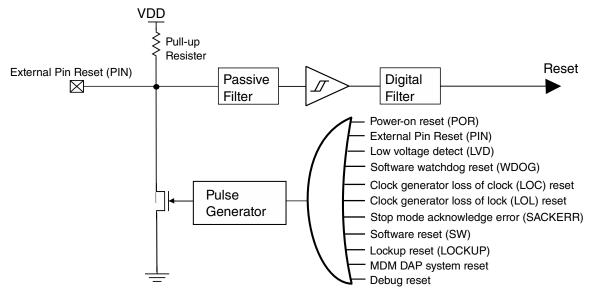


Figure 21-1. Reset Sources

21.2 Reset

This section discusses basic reset mechanisms and sources. Some modules that cause resets can be configured to cause interrupts instead. Consult the individual peripheral chapters for more information.

21.2.1 Power-on reset (POR)

When power is initially applied to the MCU or when the supply voltage drops below the power-on reset re-arm voltage level (V_{POR}), the POR circuit causes a POR reset condition.

As the supply voltage rises, the LVD circuit holds the MCU in reset until the supply has risen above the LVD low threshold (V_{LVD}). The POR and LVD bits in RCM_SRS register are set following a POR.

21.2.2 System resets

Resetting the MCU provides a way to start processing from a known set of initial conditions. System reset begins with the on-chip regulator in full regulation and system clocking generation from an internal reference. When the processor exits reset, it performs the following:

• Reads the start SP (SP_main) from vector-table offset 0

- Reads the start program counter (PC) from vector-table offset 4
- Link register (LR) is set to 0xFFFF_FFFF

The on-chip peripheral modules are disabled and the non-analog I/O pins are initially configured as disabled. The pins with analog functions assigned to them are assigned by default to their analog functions after reset.

During and following a reset, the SWD pins have their associated input pins configured as:

- SWD_CLK in pull-down (PD)
- SWD_DIO in pull-up (PU)

21.2.2.1 External pin reset (PIN)

On this device, asserting RESET wakes and resets the device from any mode. During a pin reset, RCM_SRS[PIN] is set.

The RESET pin filter supports filtering from both the 1 kHz LPO clock and the bus clock. RCM_RPC[RSTFLTSS], RCM_RPC[RSTFLTSRW], and RCM_RPC[RSTFLTSEL] control this functionality; see the RCM chapter. The filters are asynchronously reset by Chip POR. The reset value for each filter assumes the RESET pin is negated.

For all stop modes where LPO clock is still active, the only filtering option is the LPO-based digital filter. The filtering logic either switches to bypass operation or has continued filtering operation depending on the filtering mode selected.

The LPO filter has a fixed filter value of 3. Due to a synchronizer on the input data, there is also some associated latency (2 cycles). As a result, 5 cycles are required to complete a transition from low to high or high to low.

21.2.2.2 Low voltage detect (LVD)

The chip includes a system for managing low voltage conditions to protect memory contents and control MCU system states during supply voltage variations. The system consists of a power-on reset (POR) circuit and an LVD circuit. The LVD system can always be enabled in normal Run, or Wait mode. The LVD system is disabled (LVR active only) when entering VLPx modes or Stop mode.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Reset

The LVD can be configured to generate a reset upon detection of a low voltage condition by setting the PMC_LVDSC1[LVDRE] bit to 1. After an LVD reset has occurred, the LVD system holds the MCU in reset until the supply voltage has risen above the low voltage detection threshold. The RCM_SRS[LVD] bit is set following either an LVD reset or POR.

Refer to the "Low-voltage Detect (LVD) System" section in the Power Management Controller (PMC) chapter for more information. For LVR related content, see Low Voltage Reset (LVR) Operation.

21.2.2.3 Watchdog timer (WDOG)

The watchdog timer (WDOG) monitors the operation of the system by expecting periodic communication from the software. This communication is generally known as servicing (or refreshing) the watchdog. If this periodic refreshing does not occur, the watchdog issues a system reset. The reset causes the RCM_SRS[WDOG] bit to set.

21.2.2.4 Clock generator loss-of-clock (LOC)

The SCG module contains a clock monitor with reset and interrupt request capability for ROSC (OSC32) and SOSC clocks.

NOTE

To prevent unexpected loss of clock reset events, all clock monitors should be disabled before entering any low power modes, including VLPR and VLPW.

21.2.2.5 Loss-of-lock (LOL) reset

The SCG module contains a loss-of-lock detector, to indicate a reset has been caused by a loss of lock in the SCG PLL/FLL.

NOTE

This reset source does not cause a reset if the chip is in VLPR/VLPW/VLPS mode.

463

21.2.2.6 Stop mode acknowledge error (SACKERR)

This reset is generated if the core attempts to enter stop mode, but not all modules acknowledge stop mode within 1025 cycles of the LPO clock.

A module might not acknowledge the entry to stop mode if an error condition occurs. The error can be caused by a failure of an external clock input to a module.

The RCM_SRS[SACKERR] bit is set to indicate this reset source.

21.2.2.7 Software reset (SW)

The SYSRESETREQ bit in the System Control Block's (SCB) application interrupt and reset control register can be set to force a software reset on the device. (See ARM's Cortex-M user guide for the full description of the register fields, especially the VECTKEY field requirements.) Setting SYSRESETREQ generates a software reset request. This reset forces a system reset of all major components except for the debug module. A software reset causes the RCM_SRS[SW] bit to set.

21.2.2.8 Lockup reset (LOCKUP)

The LOCKUP gives immediate indication of seriously errant kernel software. This is the result of the core being locked because of an unrecoverable exception following the activation of the processor's built in system state protection hardware.

The LOCKUP condition causes a system reset and also causes the RCM_SRS[LOCKUP] bit to set.

21.2.2.9 MDM-AP system reset request

Set the system reset request bit in the MDM-AP control register to initiate a system reset. This is the primary method for resets via the SWD interface. The system reset is held until this bit is cleared.

Set the core hold reset bit in the MDM-AP control register to hold the core in reset as the rest of the chip comes out of system reset.

21.2.3 MCU Resets

A variety of resets are generated by the MCU to reset different modules.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

21.2.3.1 POR Only

The POR Only reset asserts on the POR reset source only. It resets the PMC registers.

The POR Only reset also causes all other reset types to occur.

21.2.3.2 Chip POR

The Chip POR asserts on POR, LVD Wakeup reset sources. It resets the Reset Pin Filter registers and parts of the SIM and SCG.

The Chip POR also causes the Chip Reset (including Early Chip Reset) to occur.

21.2.3.3 Early Chip Reset

The Early Chip Reset asserts on all reset sources. It resets only the flash memory module. It negates before flash memory initialization begins ("earlier" than when the Chip Reset negates).

21.2.3.4 Chip Reset

Chip Reset asserts on all reset sources and only negates after flash initialization has completed and the RESET_b pin has also negated. It resets the remaining modules (the modules not reset by other reset types).

21.2.4 Reset Pin

For all reset sources, the RESET_b pin is driven low by the MCU for at least 128 bus clock cycles and until flash initialization has completed.

After flash initialization has completed, the RESET_b pin is released, and the internal Chip Reset negates after the RESET_b pin is pulled high. Keeping the RESET_b pin asserted externally delays the negation of the internal Chip Reset.

21.3 Boot

This section describes the boot sequence, including sources and options.

465

21.3.1 Boot options

The Flash Option (FOPT) register in the Flash Memory module (FTFE_FOPT) allows the user to customize the operation of the MCU at boot time. The register contains read-only bits that are loaded from the NVM's option byte in the flash configuration field. The default setting for all values in the FTFE_FOPT register is logic 1 since it is copied from the option byte residing in flash, which has all bits as logic 1 in the flash erased state. To configure for alternate settings, program the appropriate bits in the NVM option byte. The new settings will take effect on subsequent POR and any system reset. For more details on programming the option byte, see the flash memory chapter.

The MCU uses FTFE_FOPT to configure the device at reset as shown in the following table.

Table 21-2. Flash Option Register (FTFE_FOPT) definition

Bit Num	Field	Value	Definition					
7	BOOTSRC_SEL		ource Selection: these bits select the boot sources if boot pin option bit IN_OPT (FOPT[1]) = 1.					
		воотѕ	RC_SEL (FOPT[7]) and BOOTPIN_OPT (FOPT[1]) value as below:					
		00	Boot from ROM with BOOTCFG0/NMI pin low, or Boot from Flash with BOOTCFG0/NMI pin high					
		01	Boot from Flash					
		10	Boot from ROM					
		11	Boot from ROM					
6	Reserved	Reserve	Reserved for future expansion					
5-4	Reserved	Reserved for future expansion						
3	RESET_PIN_CFG	Enables/disables control for the RESET pin.						
	function. When this option is selected, there could be a during a POR ramp where the device drives the pin low setting of this option and releasing the reset function on		RESET_b pin is disabled following a POR and cannot be enabled as reset function. When this option is selected, there could be a short period of contention during a POR ramp where the device drives the pin low prior to establishing the setting of this option and releasing the reset function on the pin. When the RESET pin is disabled and configured as a GPIO output, it operates as a pseudo open drain output.					
			This bit is preserved through system resets and low-power modes. When RESET_b pin function is disabled, it cannot be used as a source for low-power mode wake-up.					
			NOTE: When the reset pin has been disabled and security has been enabled by means of the FSEC register, a mass erase can be performed only by setting both the Mass Erase and System Reset Request fields in the MDM-AP register.					
		1	RESET_b pin is dedicated. The port is configured with pullup enabled, open drain, passive filter enabled.					
2	NMI_DIS	Enables/disables control for the NMI function.						

Table continues on the next page...

Table 21-2. Flash Option Register (FTFE_FOPT) definition (continued)

Bit Num	Field	Value	Definition			
		0	NMI interrupts are always blocked. The associated pin continues to default to NMI_b pin controls with internal pullup enabled. When NMI_b pin function is disabled, it cannot be used as a source for low-power mode wake-up.			
			If the NMI function is not required, either for an interrupt or wake up source, it is recommended that the NMI function be disabled by clearing NMI_DIS.			
		1	NMI_b pin/interrupts reset default to enabled.			
1	1 BOOTPIN_OPT		External pin selects boot options			
			Force Boot from ROM with update if BOOTCFG0 asserted, where BOOTCFG0 is the boot config function which is muxed with NMI pin. The RESET pin should be enabled when this option is selected.			
		1	Boot source configured by FOPT[7] (BOOTSRC_SEL) bitfield			
0	v		s the reset value of clock divider of IRC48M to feed the core clock. Larger divide elections produce lower average power consumption during POR and reset cing and after reset exit. The recovery times are also extended.			
		0	Low-power boot: Core and system clock divider (DIVCORE) is 0x1 (divide by 2).			
		1	Normal boot: Core and system clock divider (DIVCORE) is 0x0 (divide by 1).			

This device supports cold booting from either internal flash or Boot ROM.

When the device boots from internal flash, the reset vectors are located at address 0x0 (initial SP_main) and 0x4 (initial PC).

When the device boots from ROM, the chip will re-map the reset vectors to ROM start address at 0x1C00_0000 where SP_main is offset 0x0 and PC is offset 0x4. When Boot ROM completes, software can clear RCM mode register (RCM_MR) to disable remapping of vector fetches. Boot source can change between reset, but is always known before core reset negation. NMI input is disabled to platform when booting from ROM. See FOPT section and Reset Control Module for more detail options.

The device also supports relocating the exception vector table to RAM. This is implemented through a programmable Vector Table Offset Register (VTOR) in SCB module.

The boot options can be overridden by using RCM_FM[2:1] and RCM_MR[2:1] which can be written by software. The boot source remains set until the next System Reset or software can write logic one to clear one or both of the mode bits.

467

21.3.2 Boot sequence

At power up, the on-chip regulator holds the system in a POR state until the input supply is above the POR threshold. The system continues to be held in this static state until the internally regulated supplies have reached a safe operating voltage as determined by the LVD. The Mode Controller reset logic then controls a sequence to exit reset.

- 1. A system reset is held on internal logic, the RESET_b pin is driven out low, and the SCG is enabled in its default clocking mode.
- 2. Required clocks are enabled (Core Clock, System Clock, Flash Clock, and any Bus Clocks that do not have clock gate control reset to disabled).
- 3. The system reset on internal logic continues to be held, but the Flash Controller is released from reset and begins initialization operation while the Reset Control logic continues to drive the RESET_b pin out low.
- 4. Early in reset sequencing the NVM option byte is read and stored to the Flash Memory module's FOPT register.
- 5. When Flash Initialization completes, the RESET_b pin is released. If RESET_b continues to be asserted (an indication of a slow rise time on the RESET_b pin or external drive in low), the system continues to be held in reset. Once the RESET_b pin is detected high, the Core clock is enabled and the system is released from reset.
- 6. When the system exits reset, the processor sets up the stack, program counter (PC), and link register (LR). The processor reads the start SP (SP_main) from vector-table offset 0. The core reads the start PC from vector-table offset 4. LR is set to 0xFFFF_FFF. What happens next depends on the NMI input and the FOPT[NMI_DIS] field in the Flash Memory module:
 - If the NMI input is high or the NMI function is disabled in the NMI_DIS field, the CPU begins execution at the PC location.
 - If the NMI input is low and the NMI function is enabled in the NMI_DIS field, this results in an NMI interrupt. The processor executes an Exception Entry and reads the NMI interrupt handler address from vector-table offset 8. The CPU begins execution at the NMI interrupt handler.
- 7. If FlexNVM is enabled, the flash controller continues to restore the FlexNVM data. This data is not available immediately out of reset and the system should not access this data until the flash controller completes this initialization step as indicated by the EEERDY flag.

Subsequent system resets follow this same reset flow.

The following figure shows the boot sequence.

Boot

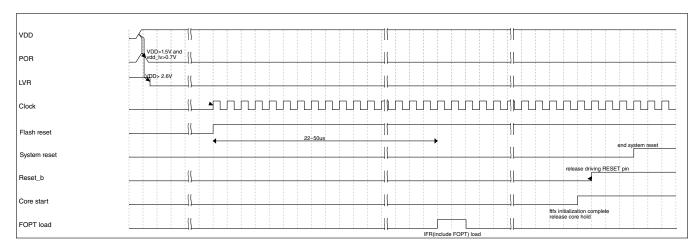


Figure 21-2. Boot Sequence

Chapter 22 Kinetis ROM Bootloader

22.1 Chip-specific information for this module

22.1.1 Boot ROM Configuration

This device contains an on-chip ROM bootloader which supports booting from LPUART, LPSPI, or LPI2C. The pinout table for peripherals supported by ROM is shown as follows.

Package			Peripheral	Instance	Signal	GPIO	ALT
100 QFP	80 QFP ¹	64 QFP	1				
53	41	33	LPUART	0	LPUART0_TX	PTB1	2
54	42	34			LPUART0_RX	PTB0	2
27	22	18	LPSPI	0	LPSPI0_PCS 1	PTB5	3
28	23	19			LPSPI0_SOU T	PTB4	3
47	39	31			LPSPI0_SIN	PTB3	3
48	40	32			LPSPI0_SCK	PTB2	3
72	59	47	LPI2C	0	LPI2C0_SCL	PTA3	3
73	60	48			LPI2C0_SDA	PTA2	3

^{1.} This package for the product is not yet available. However, it is included in Package Your Way program for Kinetis MCU. Visit nxp.com/KPYW for more details.

NOTE

For this device, ROM does not check the flash FAC function. So it is not recommended to access memory protected by FAC via ROM.

NOTE

For this device, some of the properties of the GetProperty and SetProperty commands are not available. These items are reserved, which includes: FlashBlockCount (Tag value: 06h), ReservedRegions (0Ch), ValidateRegions (0Dh), RAMStartAddress (0Eh), RAMSizeinBytes (0Fh), SystemDeviceId (10h), UniqueDeviceId (12h), FacSupport (13h), FlashAcessSegmentSize (14h) and FlashAcessSegmentCount (15h). For more information, see the table Table 22-67.

22.2 Introduction

The Kinetis bootloader is the program residing in the on-chip read-only memory (ROM) of a Kinetis microcontroller device. There is hardware logic in place at boot time that either starts execution of an embedded image available on the internal flash memory, or starts the execution of the Kinetis Bootloader from on-chip ROM.

The Kinetis Bootloader's main task is to provision the internal flash memory with an embedded firmware image during manufacturing, or at any time during the life of the Kinetis device. The Kinetis Bootloader does the provisioning by acting as a slave device, and listening to various peripheral ports where a master can start communication.

For the Kinetis device, the Kinetis Bootloader can interface with I2C, SPI, and UART peripherals in slave mode and respond to the commands sent by a master (or host) communicating on one of those ports. The host/master can be a firmware-download application running on a PC or an embedded host communicating with the Kinetis Bootloader. Regardless of the host/master (PC or embedded host), the Kinetis Bootloader always uses a command protocol to communicate with that host/master. Commands are provided to write to memory (internal flash or RAM), erase flash, and get/set bootloader options and property values. The host application can query the set of available commands.

On start-up, the bootloader reads optional configuration parameters from a fixed area on flash called the bootloader configuration area (BCA). These parameters can be modified by the write memory command or by downloaded flash image. BCA parameters include configuration data such as enabled peripherals, peripheral-specific settings, etc.

This chapter describes Kinetis Bootloader features, functionality, command structure and which peripherals are supported.

Features supported by the Kinetis Bootloader in Kinetis ROM:

- Supports I2C, SPI, and UART peripheral interfaces
- Automatic detection of the active peripheral
- Ability to disable any peripheral
- UART peripheral implements autobaud
- Common packet-based protocol for all peripherals
- Packet error detection and retransmission
- Flash-resident configuration options
- Fully supports internal flash security, including ability to mass erase or unlock security via the backdoor key
- Protection of RAM used by the bootloader while it is running
- Provides command to read properties of the device, such as flash and RAM size
- Multiple options for executing the bootloader either at system start-up or under application control at runtime
- Supports internal flash
- Supports encrypted image download

Table 22-1. Commands supported by the Kinetis Bootloader in ROM

Command	Description	When flash security is enabled, then this command is	
Execute	Run user application code that never returns control to the bootloader	Not supported	
FlashEraseAll	Erase the entire flash array	Not supported	
FlashEraseRegion	Erase a range of sectors in flash	Not supported	
WriteMemory	Write data to memory	Not supported	
FlashSecurityDisable	Attempt to unlock flash security using the backdoor key	Supported	
GetProperty	Get the current value of a property	Supported	
Reset	Reset the chip	Supported	
SetProperty	Attempt to modify a writable property	Supported	
FlashEraseAllUnsecure	Erase the entire flash array, including protected sectors	Supported	

The following sub-sections describe the Kinetis Bootloader in ROM functionality.

22.3.1 Memory Maps

While executing, the Kinetis Bootloader uses ROM and RAM memory.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

0x1C00_4000 .text 0x2000_1800 0x1C00_010 C 0x1C00_00C0 0x1C00_00C0 0x1C00_0000 0x1FFF_F800 Available, not used by ROM 0x2000_0688 ROM use

Functional Description

Figure 22-1. Kinetis Bootloader ROM/RAM Memory Maps

8KB of RAM

22.3.2 The Kinetis Bootloader Configuration Area (BCA)

16 KB of ROM

The Kinetis Bootloader reads data from the Bootloader Configuration Area (BCA) to configure various features of the bootloader. The BCA resides in flash memory at offset 0x3C0, and provides all of the parameters needed to configure the Kinetis Bootloader operation. For uninitialized flash, the Kinetis Bootloader uses a predefined default configuration. A host application can use the Kinetis Bootloader to program the BCA for use during subsequent initializations of the bootloader.

Table 22-2. Configuration Fields for the Kinetis Bootloader

Offset	Size (bytes)	Configuration Field	Description
0x00 - 0x03	4	tag	Magic number to verify bootloader configuration is valid. Must be set to 'kcfg'.
0x04 - 0x07	4	-	Reserved in
0x08 - 0x0B	4	-	Reserved in
0x0C - 0x0F	4	-	Reserved in
0x10	1	enabledPeripherals	Bitfield of peripherals to enable.
			bit 0 LPUART
			bit 1 LPI2C
			bit 2 LPSPI
			Kinetis bootloader will enable the peripheral if corresponding bit is set to 1.

Table continues on the next page...

Table 22-2. Configuration Fields for the Kinetis Bootloader (continued)

Offset	Size (bytes)	Configuration Field	Description
0x11	1	i2cSlaveAddress	If not 0xFF, used as the 7-bit I2C slave address. If 0xFF, defaults to 0x10 for I2C slave address
0x12 - 0x13	2	peripheralDetectionTimeout	Timeout in milliseconds for active peripheral detection. If 0xFFFF, defaults to 5 seconds.
0x14 - 0x15	2	-	Reserved
0x16- 0x17	2	-	Reserved in
0x18 - 0x1B	4	-	Reserved in
0x1C	1	clockFlags	See Table 22-4, clockFlags Configuration Field
0x1D	1	clockDivider	Inverted value of the divider to use for core and bus clocks when in high speed mode
0x1F	1	pad byte	N/A
0x20	4	Reserved	-
0x24 - 0x27	8	Reserved	-
0x29 - 0x2F	7	Reserved	-
0x28	1	Reserved	-
0x30	4	Reserved	-
0x34	12	Reserved	-

NOTE

The flash sector containing the BCA should not be located in the execute-only region, because the Kinetis bootloader cannot read an execute-only region.

The first configuration field 'tag' is a tag value or magic number. The tag value must be set to 'kcfg' for the bootloader configuration data to be recognized as valid. If tag-field verification fails, then the Kinetis Bootloader assumes that the flash is not initialized and uses a predefined default configuration. The tag value is treated as a character string, so bytes 0-3 must be set as shown in the table.

Table 22-3. tag Configuration Field

Offset	tag Byte Value
0	'k' (0x6B)
1	'c' (0x63)
2	'f' (0x66)
3	'g' (0x67)

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

The flags in the clockFlags configuration field are enabled if the corresponding bit is cleared (0).

Table 22-4. clockFlags Configuration Field

Bit	Flag	Description
0		Enable high speed mode (i.e., 48 MHz). Read Clock Configuration section for more information on the high speed mode.
1 - 7	Reserved	

22.3.3 Start-up Process

Any of the following conditions will force the hardware to start the Kinetis Bootloader:

- FOPT [7] is set to 1. This forces the ROM to run out of reset.
- The BOOTCFG0 pin is asserted. The pin must be configured as BOOTCFG0 by setting the BOOTPIN_OPT bit of FOPT to 0.
- A user applications running on flash or RAM calls into the Kinetis Bootloader entry point address in ROM, to start Kinetis Bootloader execution.

The FOPT[BOOTSRC_SEL] determines the boot source. The FOPT register is located in the flash configuration field at address 0x40D in the flash memory array. For a complete list of options, see the Boot options section in the Reset and Boot chapter. If FOPT [7] is set to 1, then the device will boot to ROM out of reset. Flash memory defaults to all 1s when erased, so a blank chip will automatically boot to ROM.

The BOOTCFG0 pin is shared with the NMI pin, with NMI being the default usage. Regardless of whether the NMI pin is enabled or not, the NMI functionality is disabled if the ROM is executed out of reset, for as long as the ROM is running.

When the ROM is executed out of reset, vector fetches from the CPU are redirected to the ROM's vector table in ROM memory at offset 0x1C00_0000. This ensures that any exceptions will be handled by the ROM.

After the Kinetis Bootloader has started, the following procedure starts bootloader operations:

- 1. The RCM_MR [BOOTROM] bits are set, so that the device will reboot back into the ROM if/when the device is reset.
- 2. Initializes the bootloader's .data and .bss sections.
- 3. Reads bootloader configuration data from flash at address 0x3C0. The configuration data is only used if the tag field is set to the expected 'kcfg' value. If the tag is incorrect, then the configuration values are set to default, as if the data was all 0xFF bytes.

- 4. Clocks are configured. See the Clock Configuration section.
- 5. Enabled peripherals are initialized.
- 6. The bootloader waits for communication to begin on a peripheral.
 - If detection times out, then the bootloader jumps to the user application in flash. See Bootloader Exit state section.
 - If communication is detected, then all inactive peripherals are shut down, and the command phase is entered.

NOTE

The flash sector containing the vector table should not be located in the execute-only region, because the Kinetis bootloader cannot read the PC and SP addresses in an execute-only region.

Functional Description Enter Bootloader Shutdown Jump to all peripherals user application Init hardware Yes Init flash driver s Timeout check enabled and has Timeout occurred? Load user-config data Nο Configure clocks; Was a Ping packet Init microseconds Shutdown received on LPSPIn? driver, memory & unused peipherals property interface Nο No LPUARTn, LPSPIn LPI2Cn Was a Ping packet Use the enabledPeripherals field state machine received on LPI2Cn? in user config data to enable (or not) LPUARTn (or LPSPIn or LPI2Cn) No Is BootPin Was a Ping packet received on LPUARTn? No **Enable Timeout** Yes Yes application check and enable

Figure 22-2. Kinetis Bootloader Start-up Flowchart

Timeout value

Clock Configuration 22.3.4

valid?

Disable Timeout detection

No

By default, the bootloader does not modify clocks. The Kinetis Bootloader in ROM will use the clock configuration of the chip out of reset unless the clock configuration bits in the FOPT register are cleared.

- Alternate clock configurations are supported, by setting fields in the Bootloader Configuration Area (BCA) shown in Table 22-2.
- If the HighSpeed flag of the clockFlags configuration value is cleared, the bootloader will enable the internal 48 MHz reference clock.

- In high speed mode, the core and bus clock frequencies are determined by the clockDivider configuration value.
- The core clock divider is set directly from the inverted value of the clockDivider.
- The bus clock divider is set to 1, unless the resulting bus clock frequency would be greater than the maximum supported value. In this case, the bus clock divider is increased until the bus clock frequency is at or below the maximum.
- Note that the maximum baud rate of serial peripherals is related to the core and bus clock frequencies. To achieve the desired baud rates, high speed mode should be enabled in BCA.

22.3.5 Bootloader Entry Point / API Tree

To run the Kinetis Bootloader, a user application simply calls the runBootloader function. To get the address of the entry point, the user application reads the word containing the pointer to the bootloader API tree at offset 0x1C of the bootloader's vector table. The vector table is placed at the base of the bootloader's address range, which for the ROM is 0x1C00_0000; the API tree pointer is at address 0x1C00_001C.

The bootloader API tree is a structure that contains pointers to other structures, which have the function and data addresses for the bootloader. The bootloader entry point is always the 1st word of the API tree.

The prototype of the entry point is:

```
void run_bootloader(void * arg);
```

The arg parameter is currently unused, and is intended for future expansion (for example, passing options to the bootloader). To ensure future compatibility, a value of NULL should be passed for arg.

Example: code to get the entry pointer address from the ROM and start the bootloader.

NOTE

This entry must be called in supervisor (privileged) mode.

// Variables

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

```
uint32_t runBootloaderAddress;
void (*runBootloader) (void * arg);

// Read the function address from the ROM API tree.
runBootloaderAddress = **(uint32_t **)(0x1c00001c);
runBootloader = (void (*)(void * arg))runBootloaderAddress;

// Start the bootloader.
runBootloader(NULL);
```

22.3.6 Bootloader Protocol

This section explains the general protocol for the packet transfers between the host and the Kinetis Bootloader. The description includes the transfer of packets for different transactions, such as commands with no data phase and commands with incoming or outgoing data phase. The next section describes various packet types used in a transaction.

Each command sent from the host is replied to with a response command.

Commands may include an optional data phase:

- If the data phase is **incoming** (from host to bootloader), then the data phase is part of the **original command**.
- If the data phase is **outgoing** (from bootloader to host), then the data phase is part of the **response command**.

NOTE

In all protocols (described in the next subsections), the Ack sent in response to a Command or Data packet can arrive at any time *before, during, or after* the Command/Data packet has processed.

22.3.6.1 Command with no data phase

The protocol for a command with no data phase contains:

- Command packet (from host)
- Generic response command packet (to host)

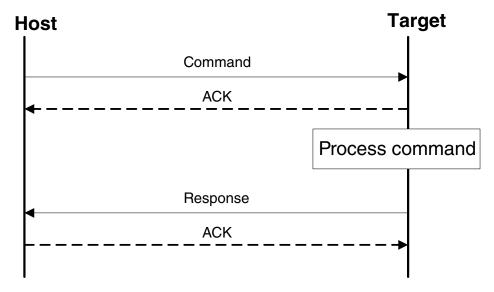


Figure 22-3. Command with No Data Phase

22.3.6.2 Command with incoming data phase

The protocol for a command with an incoming data phase contains:

- Command packet (from host)
- Generic response command packet (to host)
- Incoming data packets (from host)
- Generic response command packet (to host)

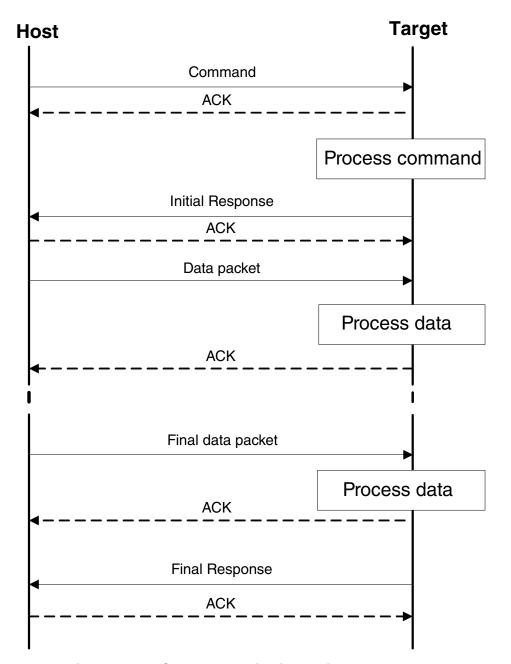


Figure 22-4. Command with incoming data phase

NOTE

- The host may not send any further packets while it (the host) is waiting for the response to a command.
- If the Generic Response packet prior to the start of the data phase does not have a status of kStatus_Success, then the data phase is aborted.
- Data phases may be aborted by the receiving side by sending the final Generic Response early with a status of

- kStatus_AbortDataPhase. The host may abort the data phase early by sending a zero-length data packet.
- The final Generic Response packet *sent after the data phase* includes the status for the entire operation.

22.3.6.3 Command with outgoing data phase

For, there is no command available with an outgoing data phase.

22.3.7 Bootloader Packet Types

The Kinetis Bootloader device works in slave mode. All data communication is initiated by a host, which is either a PC or an embedded host. The Kinetis Bootloader device is the target, which receives a command or data packet. All data communication between host and target is packetized.

NOTE

The term "target" refers to the "Kinetis Bootloader device."

There are 6 types of packets used in the device:

- Ping packet
- Ping Response packet
- Framing packet
- Command packet
- Data packet
- Response packet

All fields in the packets are in little-endian byte order.

22.3.7.1 Ping packet

The Ping packet is the first packet sent from a host to the target (Kinetis Bootloader), to establish a connection on a selected peripheral. For a UART peripheral, the Ping packet is used to determine the baudrate. A Ping packet must be sent before any other communications. In response to a Ping packet, the target sends a Ping Response packet.

Table 22-5. Ping Packet Format

Byte #	Value	Name
0	0x5A	start byte
1	0xA6	ping

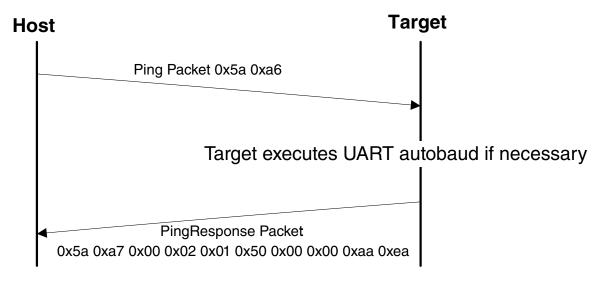


Figure 22-5. Ping Packet Protocol Sequence

22.3.7.2 Ping Response Packet

The target (Kinetis Bootloader) sends a Ping Response packet back to the host after receiving a Ping packet. If communication is over a UART peripheral, the target uses the incoming Ping packet to determine the baud rate before replying with the Ping Response packet. Once the Ping Response packet is received by the host, the connection is established, and the host starts sending commands to the target (Kinetis Bootloader).

Byte #	Value	Parameter
0	0x5A	start byte
1	0xA7	Ping response code
2		Protocol bugfix
3		Protocol minor
4		Protocol major
5		Protocol name = 'P' (0x50)
6		Options low
7		Options high
8		CRC16 low
9		CRC16 high

Table 22-6. Ping Response Packet Format

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

483

22.3.7.3 Framing Packet

The framing packet is used for flow control and error detection, and it (the framing packet) wraps command and data packets as well.

The framing packet described in this section is used for serial peripherals including UART, I2C, SPI.

Value **Parameter** Byte # 0 0x5A start byte packetType 2 length_low Length is a 16-bit field that specifies the entire command or data packet size in bytes. 3 length_high 4 crc16 low This is a 16-bit field. The CRC16 value covers entire framing packet, including the start byte and command 5 crc16_high or data packets, but does not include the CRC bytes. See the CRC16 algorithm after this table. 6 . . .n Command or Data packet payload

Table 22-7. Framing Packet Format

A special framing packet that contains only a start byte and a packet type is used for synchronization between the host and target.

 Byte #
 Value
 Parameter

 0
 0x5A
 start byte

 1
 0xAn
 packetType

Table 22-8. Special Framing Packet Format

The Packet Type field specifies the type of the packet from one of the defined types (below):

Table 22-9. packetType Field

packetType	Name	Description
0xA1	kFramingPacketType_Ack	The previous packet was received successfully; the sending of more packets is allowed.
0xA2	kFramingPacketType_Nak	The previous packet was corrupted and must be re-sent.
0xA3	kFramingPacketType_AckAbort	Data phase is being aborted.
0xA4	kFramingPacketType_Command	The framing packet contains a command packet payload.
0xA5	kFramingPacketType_Data	The framing packet contains a data packet payload.
0xA6	kFramingPacketType_Ping	Sent to verify the other side is alive. Also used for UART autobaud.

Table continues on the next page...

NXP Semiconductors

Table 22-9. packetType Field (continued)

packetType	Name	Description
0xA7	, , , , , , , , , , , , , , , , , , , ,	A response to Ping; contains the framing protocol version number and options.

This device uses the Cyclic Redundancy Check module (CRC) to perform the CRC algorithm. See the CRC chapter for more details.

22.3.7.4 Command packet

The command packet carries a 32-bit command header and a list of 32-bit parameters.

Table 22-10. Command Packet Format

	Command Packet Format (32 bytes)									
Com	Command Header (4 bytes) 28 bytes for Parameters (Max 7 parameters)									
Tag	Flags	Rsvd	Param Count	Param1 (32-bit)	Param2 (32-bit)	Param3 (32-bit)	Param4 (32-bit)	Param5 (32-bit)	Param6 (32-bit)	Param7 (32-bit)
byte 0	byte 1	byte 2	byte 3							

Table 22-11. Command Header Format

Byte #	Command Header Field	
0	Command or Response tag	The command header is 4 bytes long, with
1	Flags	these fields.
2	Reserved. Should be 0x00.	
3	ParameterCount	

The header is followed by 32-bit parameters up to the value of the ParameterCount field specified in the header. Because a command packet is 32 bytes long, only 7 parameters can fit into the command packet.

Command packets are also used by the target to send responses back to the host. As mentioned earlier, command packets and data packets are embedded into framing packets for all of the transfers.

Table 22-12. Commands that are supported

Command	Name
0x01	FlashEraseAll
0x02	FlashEraseRegion
0x03	Reserved

Table continues on the next page...

NXP Semiconductors

Table 22-12. Commands that are supported (continued)

Command	Name
0x04	WriteMemory
0x05	Reserved
0x06	FlashSecurityDisable
0x07	GetProperty
0x08	Reserved
0x09	Execute
0x0A	Reserved
0x0B	Reset
0x0C	SetProperty
0x0D	FlashEraseAllUnsecure
0x0E	Reserved
0x0F	Reserved
0x10	Reserved
0x11	Reserved
0x12	Reserved

Table 22-13. Responses that are supported

Response	Name
0xA0	GenericResponse
0xA7	GetPropertyResponse (used for sending responses to GetProperty command only)

Flags: Each command packet contains a Flag byte. Only bit 0 of the flag byte is used. If bit 0 of the flag byte is set to 1, then data packets will follow in the command sequence. The number of bytes that will be transferred in the data phase is determined by a command-specific parameter in the parameters array.

ParameterCount: The number of parameters included in the command packet.

Parameters: The parameters are word-length (32 bits). With the default maximum packet size of 32 bytes, a command packet can contain up to 7 parameters.

22.3.7.5 Data packet

The data packet carries just the data, either host sending data to target, or target sending data to host. The data transfer direction is determined by the last command sent from the host. The data packet is also wrapped within a framing packet, to ensure the correct packet data is received.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

The contents of a data packet are simply the data itself. There are no other fields, so that the most data per packet can be transferred. Framing packets are responsible for ensuring that the correct packet data is received.

22.3.7.6 Response packet

The responses are carried using the same command packet format wrapped with framing packet data. Types of responses include:

- GenericResponse
- GetPropertyResponse

GenericResponse: After the Kinetis Bootloader has processed a command, the bootloader will send a generic response with status and command tag information to the host. The generic response is the last packet in the command protocol sequence. The generic response packet contains the framing packet data and the command packet data (with generic response tag = 0xA0) and a list of parameters (defined in the next section). The parameter count field in the header is always set to 2, for status code and command tag parameters.

Table 22-14. GenericResponse Parameters

Byte #	Parameter	Descripton
0 - 3		The Status codes are errors encountered during the execution of a command by the target (Kinetis Bootloader). If a command succeeds, then a kStatus_Success code is returned. Table 22-71, Kinetis Bootloader Status Error Codes, lists the status codes returned to the host by the Kinetis Bootloader for ROM.
4 - 7	Command tag	The Command tag parameter identifies the response to the command sent by the host.

GetPropertyResponse: The GetPropertyResponse packet is sent by the target in response to the host query that uses the GetProperty command. The GetPropertyResponse packet contains the framing packet data and the command packet data, with the command/response tag set to a GetPropertyResponse tag value (0xA7).

The parameter count field in the header is set to greater than 1, to always include the status code and one or many property values.

Table 22-15. GetPropertyResponse Parameters

Byte #	Value	Parameter
0 - 3		Status code

Table continues on the next page...

Table 22-15. GetPropertyResponse Parameters (continued)

Byte #	Value	Parameter
4 - 7		Property value
		Can be up to maximum 6 property values, limited to the size of the 32-bit command packet and property type.

22.3.8 **Bootloader Command API**

All Kinetis Bootloader command APIs follow the command packet format that is wrapped by the framing packet, as explained in previous sections.

- For a list of commands supported by the Kinetis Bootloader in ROM, see Table 22-1, Commands supported.
- For a list of status codes returned by the Kinetis Bootloader in ROM, see Table 22-71, Kinetis Bootloader Status Error Codes.

NOTE

All the examples in this section depict byte traffic on serial peripherals that use framing packets.

22.3.8.1 **Execute command**

The execute command results in the bootloader setting the program counter to the code at the provided jump address, R0 to the provided argument, and a Stack pointer to the provided stack pointer address. Prior to the jump, the system is returned to the reset state.

The Jump address, function argument pointer, and stack pointer are the parameters required for the Execute command.

Table 22-16. Parameters for Execute Command

Byte #	Command
0 - 3	Jump address
4 - 7	Argument word
8 - 11	Stack pointer address

The Execute command has no data phase.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018 **NXP Semiconductors** 487

Response: Before executing the Execute command, the target (Kinetis Bootloader) will validate the parameters and return a GenericResponse packet with a status code either set to kStatus_Success or an appropriate error status code.

22.3.8.2 Reset command

The Reset command will result in bootloader resetting the chip.

The Reset command requires no parameters.

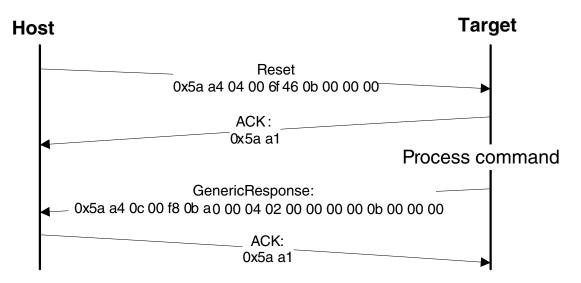


Figure 22-6. Protocol Sequence for Reset Command

Reset	Parameter	Value
Framing packet	start byte	0x5A
	packetType	0xA4, kFramingPacketType_Command
	length	0x04 0x00
	crc16	0x6F 0x46
Command packet	commandTag	0x0B - reset
	flags	0x00
	reserved	0x00
	parameterCount	0x00

Table 22-17. Reset Command Packet Format (Example)

The Reset command has no data phase.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018 488 NXP Semiconductors

489

Response: The target (Kinetis Bootloader) will return a GenericResponse packet with status code set to kStatus_Success, before resetting the chip.

22.3.8.3 GetProperty command

The GetProperty command is used to query the bootloader about various properties and settings. Each supported property has a unique 32-bit tag associated with it. The tag occupies the first parameter of the command packet. The target returns a GetPropertyResponse packet with the property values for the property identified with the tag in the GetProperty command.

Properties are the defined units of data that can be accessed with the GetProperty or SetProperty commands. Properties may be read-only or read-write. All read-write properties are 32-bit integers, so they can easily be carried in a command parameter.

For a list of properties and their associated 32-bit property tags supported by the Kinetis Bootloader in ROM, see Table 22-67.

The 32-bit property tag is the only parameter required for GetProperty command.

Table 22-18. Parameters for GetProperty Command

Byte #	Command
0 - 3	Property tag

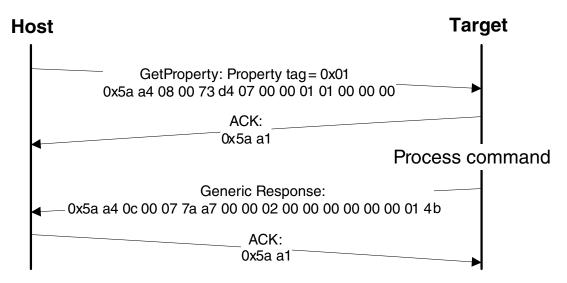


Figure 22-7. Protocol Sequence for GetProperty Command

Table 22-19. GetProperty Command Packet Format (Example)

GetProperty	Parameter	Value
Framing packet	start byte	0x5A
	packetType	0xA4, kFramingPacketType_Command
	length	0x08 0x00
	crc16	0x73 0xD4
Command packet	commandTag	0x07 – GetProperty
	flags	0x00
	reserved	0x00
	parameterCount	0x01
	propertyTag	0x0000001 - CurrentVersion

The GetProperty command has no data phase.

Response: In response to a GetProperty command, the target will send a GetPropertyResponse packet with the response tag set to 0xA7. The parameter count indicates the number of parameters sent for the property values, with the first parameter showing status code 0, followed by the property value(s). The next table shows an example of a GetPropertyResponse packet.

Table 22-20. GetProperty Response Packet Format (Example)

GetPropertyResponse	Parameter	Value
Framing packet	start byte	0x5A
	packetType	0xA4, kFramingPacketType_Command
	length	0x0c 0x00 (12 bytes)
	crc16	0x07 0x7a
Command packet	responseTag	0xA7
	flags	0x00
	reserved	0x00
	parameterCount	0x02
	status	0x00000000
	propertyValue	0x0000014b - CurrentVersion

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018 490 **NXP Semiconductors**

22.3.8.4 SetProperty command

The SetProperty command is used to change or alter the values of the properties or options in the Kinetis Bootloader ROM. However, the SetProperty command can only change the value of properties that are writable—see Table 22-67, Properties used by Get/SetProperty Commands. If you try to set a value for a read-only property, then the Kinetis Bootloader will return an error.

The property tag and the new value to set are the 2 parameters required for the SetProperty command.

Byte #	Command
0 - 3	Property tag
4 - 7	Property value

Table 22-21. Parameters for SetProperty Command

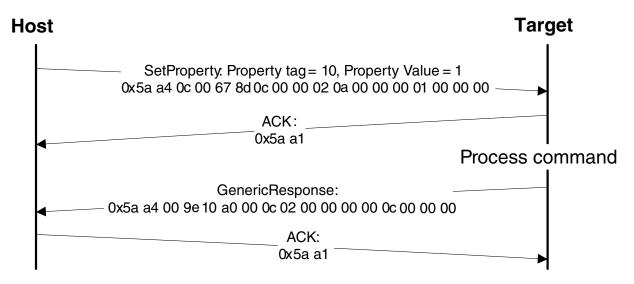


Figure 22-8. Protocol Sequence for SetProperty Command

SetProperty	Parameter	Value
Framing packet	start byte	0x5A
	packetType	0xA4, kFramingPacketType_Command
	length	0x0C 0x00
	crc16	0x67 0x8D
Command packet	commandTag	0x0C – SetProperty with property tag 10
	flags	0x00

Table 22-22. SetProperty Command Packet Format (Example)

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Table 22-22. SetProperty Command Packet Format (Example) (continued)

SetProperty	Parameter	Value
	reserved	0x00
	parameterCount	0x02
	propertyTag	0x000000A - VerifyWrites
	propertyValue	0x0000001

The SetProperty command has no data phase.

Response: The target (Kinetis Bootloader) will return a GenericResponse packet with one of following status codes:

Table 22-23. SetProperty Response Status Codes

Status Code
kStatus_Success
kStatus_ReadOnly
kStatus_UnknownProperty
kStatus_InvalidArgument

22.3.8.5 FlashEraseAll command

The FlashEraseAll command performs an erase of the entire flash memory. If any flash regions are protected, then the FlashEraseAll command will fail and return an error status code. Executing the FlashEraseAll command will release flash security if it (flash security) was enabled, by setting the FTFE_FSEC register. However, the FSEC field of the flash configuration field is erased, so unless it is reprogrammed, the flash security will be re-enabled after the next system reset. The Command tag for FlashEraseAll command is 0x01 set in the commandTag field of the command packet.

The FlashEraseAll command requires no parameters.

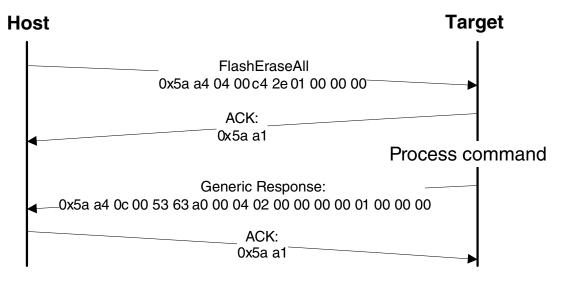


Figure 22-9. Protocol Sequence for FlashEraseAll Command

FlashEraseAll	Parameter	Value	
Framing packet	start byte	0x5A	
	packetType	0xA4, kFramingPacketType_Command	
	length	0x04 0x00	
	crc16	0xC4 0x2E	
Command packet	commandTag	0x01 - FlashEraseAll	
	flags	0x00	
	reserved	0x00	
	parameterCount	0x00	
	MemoryID	 If MemoryID = 0x00h, then internal flash. If MemoryID = 0x01h, then QSPI0 memory. 	

Table 22-24. FlashEraseAll Command Packet Format (Example)

The FlashEraseAll command has no data phase.

Response: The target (Kinetis Bootloader) will return a GenericResponse packet with status code either set to kStatus_Success for successful execution of the command, or set to an appropriate error status code.

22.3.8.6 FlashEraseRegion command

The FlashEraseRegion command performs an erase of one or more sectors of the flash memory or a specified range of flash within the connected SPI flash devices.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

The start address and number of bytes are the 2 parameters required for the FlashEraseRegion command. The start and byte count parameters must be, or the FlashEraseRegion command will fail and return kStatus_FlashAlignmentError (0x101). If the region specified does not fit in the flash memory space, the FlashEraseRegion command will fail and return kStatus_FlashAddressError (0x102). If any part of the region specified is protected, the FlashEraseRegion command will fail and return kStatus_MemoryRangeInvalid (0x10200).

Table 22-25. Parameters for FlashEraseRegion Command

Byte #	Parameter
0 - 3	Start address
4 - 7	Byte count

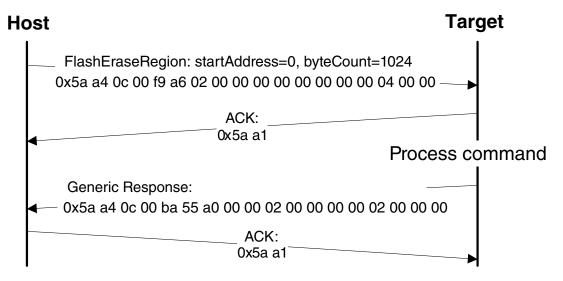


Figure 22-10. Protocol Sequence for FlashEraseRegion Command

Table 22-26. FlashEraseRegion Command Packet Format (Example)

FlashEraseRegion	Parameter	Value
Framing packet	start byte	0x5A
	packetType	0xA4, kFramingPacketType_Command
	length	0x0C 0x00
	crc16	0xF9 0x A6
Command packet	commandTag	0x02, kCommandTag_FlashEraseRegion
	flags	0x00
	reserved	0x00
	parameterCount	0x02
	startAddress	0x00 0x00 0x00 0x00 (0x0000_0000)
	byte count	0x00 0x04 0x00 0x00 (0x400)

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

495

The FlashEraseRegion command has no data phase.

Response: The target (Kinetis Bootloader) will return a GenericResponse packet with one of following error status codes.

Table 22-27. FlashEraseRegion Response Status Codes

Status Code
kStatus_Success (0x0)
kStatus_MemoryRangeInvalid (0x10200)
kStatus_FlashAlignmentError (0x101)
kStatus_FlashAddressError (0x102)
kStatus_FlashAccessError (0x103)
kStatus_FlashProtectionViolation (0x104)
kStatus_FlashCommandFailure (0x105)

22.3.8.7 FlashEraseAllUnsecure command

The FlashEraseAllUnsecure command performs a mass erase of the flash memory, including protected sectors. Flash security is immediately disabled if it (flash security) was enabled, and the FSEC byte in the flash configuration field at address 0x40C is programmed to 0xFE. However, if the mass erase enable option in the FSEC field is disabled, then the FlashEraseAllUnsecure command will fail.

The FlashEraseAllUnsecure command requires no parameters.

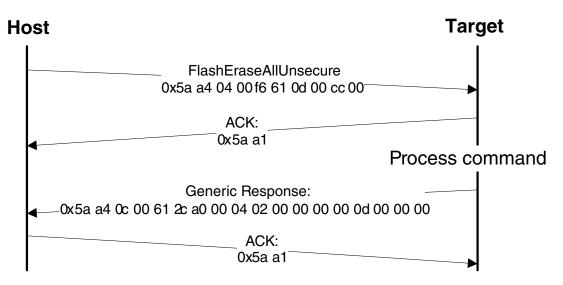


Figure 22-11. Protocol Sequence for FlashEraseAll Command

Table 22-28. FlashEraseAllUnsecure Command Packet Format (Example)

FlashEraseAllUnsecure	Parameter	Value
Framing packet	start byte	0x5A
	packetType	0xA4, kFramingPacketType_Command
	length	0x04 0x00
	crc16	0xF6 0x61
Command packet	commandTag	0x0D - FlashEraseAllUnsecure
	flags	0x00
	reserved	0x00
	parameterCount	0x00

The FlashEraseAllUnsecure command has no data phase.

Response: The target (Kinetis Bootloader) will return a GenericResponse packet with status code either set to kStatus_Success for successful execution of the command, or set to an appropriate error status code.

22.3.8.8 FlashSecurityDisable command

The FlashSecurityDisable command performs the flash security disable operation, by comparing the 8-byte backdoor key (provided in the command) against the backdoor key stored in the flash configuration field (at address 0x400 in the flash).

The backdoor low and high words are the only parameters required for FlashSecurityDisable command.

Table 22-29. Parameters for FlashSecurityDisable Command

Byte #	Command
0 - 3	Backdoor key low word
4 - 7	Backdoor key high word

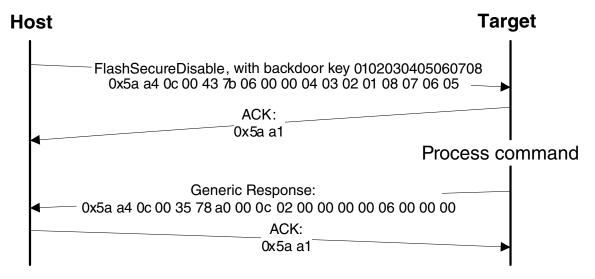


Figure 22-12. Protocol Sequence for FlashSecurityDisable Command

FlashSecurityDisable	Parameter	Value
Framing packet	start byte	0x5A
	packetType	0xA4, kFramingPacketType_Command
	length	0x0C 0x00
	crc16	0x43 0x7B
Command packet	commandTag	0x06 - FlashSecurityDisable
	flags	0x00
	reserved	0x00
	parameterCount	0x02
	Backdoorkey_low	0x04 0x03 0x02 0x01
	Backdoorkey high	0x08 0x07 0x06 0x05

Table 22-30. FlashSecurityDisable Command Packet Format (Example)

The FlashSecurityDisable command has no data phase.

Response: The target (Kinetis Bootloader) will return a GenericResponse packet with a status code either set to kStatus_Success upon successful execution of the command, or set to an appropriate error status code.

22.3.8.9 WriteMemory command

The WriteMemory command writes data provided in the data phase to a specified range of bytes in memory (flash or RAM). However, if flash protection is enabled, then writes to protected sectors will fail.

Special care must be taken when writing to flash.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

- First, any flash sector written to must have been previously erased with a FlashEraseAll, FlashEraseRegion, or FlashEraseAllUnsecure command.
- Writing to flash requires the start address to be 4-byte aligned ([1:0] = 00).
- The byte count will be rounded up to a multiple of 4, and the trailing bytes will be filled with the flash erase pattern (0xff).
- If the VerifyWrites property is set to true, then writes to flash will also perform a flash verify program operation.

When writing to RAM, the start address need not be aligned, and the data will not be padded.

The start address and number of bytes are the 2 parameters required for WriteMemory command.

Table 22-31. Parameters for WriteMemory Command

Byte #	Command
0 - 3	Start address
4 - 7	Byte count

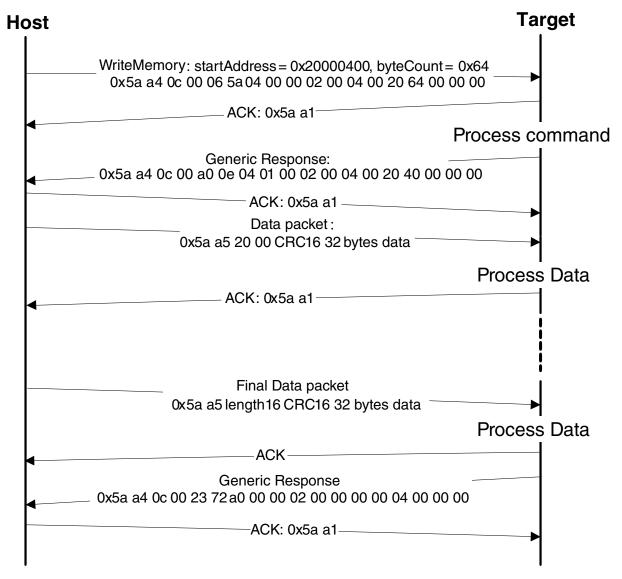


Figure 22-13. Protocol Sequence for WriteMemory Command

Table 22-32. WriteMemory Command Packet Format (Example)

WriteMemory	Parameter	Value
Framing packet	start byte	0x5A
	packetType	0xA4, kFramingPacketType_Command
	length	0x0C 0x00
	crc16	0x06 0x5A
Command packet	commandTag	0x04 - writeMemory
	flags	0x00
	reserved	0x00
	parameterCount	0x02
	startAddress	0x20000400
	byteCount	0x0000064

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Data Phase: The WriteMemory command has a data phase; the host will send data packets until the number of bytes of data specified in the byteCount parameter of the WriteMemory command are received by the target.

Response: The target (Kinetis Bootloader) will return a GenericResponse packet with a status code set to kStatus_Success upon successful execution of the command, or to an appropriate error status code.

22.3.9 Bootloader Exit state

The Kinetis Bootloader tries to reconfigure the system back to the reset state in the following situations:

- After completion of an Execute command, but before jumping to the specified entry point.
- After a peripheral detection timeout, but before jumping to the application entry point.

22.4 Kinetis Flash Driver API

To simplify flash code development, the Kinetis ROM Bootloader has flash driver APIs that user applications can use, and provides pointers to where these APIs are located. This section describes how to use each flash driver API provided in the Kinetis flash driver API tree.

NOTE

For more information on how to use the ROM-resident Flash Driver API from an application space, see the "Kinetis Flash Driver API" chapter of the latest "Kinetis Bootloader Reference Manual," http://www.nxp.com/KBOOT.

22.4.1 Flash Driver Entry Point

The MCU ROM bootloader provides a flash driver API tree entry (flashDriver) that a user application can use to get the entry points for the whole flash API set that is supported by the bootloader.

NOTE

The flashloader and flash-resident bootloader do not support this feature (flash driver API tree).

To get the address of the entry point, the user application reads the word containing the pointer to the bootloader API tree at offset 0x1C of the bootloader's vector table. The vector table is placed at the base of the bootloader's address range.

22.4.2 Flash driver API Tree

The bootloader API tree is a structure that contains pointers to other structures, which have the function and data address for the bootloader. The Flash driver API tree entry is always the 5th word of the API tree.

The prototype of the entry point is:

```
flash_driver_interface_t flashDriver;
```

There are several slightly different versions of the flash driver API among different targets with ROM bootloader.

Table 22-33.	Different	versions	of th	e flash	driver
I abic ZZ ou.		VCI 310113	VI 111	c masm	MIIV CI

Flash driver API version	Supported targets		
V1.0	KL03Z4 KL43Z4 KL33Z4 KL27Z4 KL17Z4		
V1.1	KL27Z644 KL17Z644		
V1.2	KL13Z644 KL33Z644 K80F256 K81F256 K82F256 KL81Z7 KL82Z7 KL28Z7		

There are minor differences in the flash driver interface among the flash driver API versions. See the definitions below.

```
typedef union BootloaderVersion
{
    struct
    {
        uint32_t bugfix : 8; //!lt; bugfix version [7:0]
        uint32_t minor : 8; //!lt; minor version [15:8]
        uint32_t major : 8; //!lt; major version [23:16]
        uint32_t name : 8; //!lt; name [31:24]
    } B;
    uint32_t version; //!lt; combined version numbers
} standard_version_t;

//! @brief Interface for the flash driver.
typedef struct FlashDriverInterface
{
#if !defined(FLASH_API_TREE_1_0)
        standard_version_t version; //!lt; flash driver API version number.
#endif
```

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

```
status t (*flash init)(flash config t *config);
#if defined(FLASH API TREE 1 0)
    status_t (*flash_erase_all)(flash_config_t *config);
    status t (*flash erase all unsecure)(flash config t *config);
    status_t (*flash_erase)(flash_config_t *config, uint32_t start, uint32_t lengthInBytes);
#else
    status t (*flash erase all)(flash config t *config, uint32 t key);
    status t (*flash erase all unsecure) (flash config t *config, uint32 t key);
    status_t (*flash_erase)(flash_config_t *config, uint32_t start, uint32_t lengthInBytes,
uint32 t key);
#endif
    status t (*flash program) (flash config t *config, uint32 t start, uint32 t *src,
uint32 t lengthInBytes);
   status t (*flash get security state) (flash config t *config, flash security state t
    status t (*flash security bypass) (flash config t *config, const uint8 t *backdoorKey);
    status_t (*flash_verify_erase_all)(flash_config_t *config, flash_margin_value_t margin);
    status t (*flash verify erase) (flash config t *config,
                                   uint32_t start,
                                   uint32 t lengthInBytes,
                                   flash margin value t margin);
    status t (*flash verify program) (flash config t *config,
                                     uint32_t start,
                                     uint32_t lengthInBytes,
                                     const uint32 t *expectedData,
                                     flash_margin_value_t margin,
                                     uint32_t *failedAddress,
                                     uint32 t *failedData);
    status_t (*flash_get_property)(flash_config_t *config, flash_property_tag_t
whichProperty, uint32_t *value);
#if (!defined(FLASH API TREE 1 0)) && (!defined(FLASH API TREE 1 1))
    status_t (*flash_register_callback)(flash_config_t *config, flash_callback_t callback);
    status t (*flash program once) (flash config t *config, uint32 t index, uint32 t *src,
uint32 t lengthInBytes);
    status t (*flash read once) (flash config t *config, uint32 t index, uint32 t *dst,
uint32 t lengthInBytes);
    status t (*flash read resource) (flash config t *config,
                                    uint32 t start,
                                    uint32 t *dst,
                                    uint32 t lengthInBytes,
                                    flash read resource option t option);
#endif
} flash driver interface t;
```

The Freescale/NXP standard flash driver (C90TFS flash driver) is the basis for the flash driver API.

22.4.3 Quick demo using Kinetis Flash Driver API

The example code below uses the Kinetis Flash Driver API to erase a region of flash memory. For more code examples, get the latest Kinetis bootloader package at http://www.nxp.com/KBOOT/

22.4.4 Flash driver data structures

22.4.4.1 flash_config_t

The <code>flash_config_t</code> data structure is a required argument for all flash driver API functions. <code>flash_config_t</code> is initialized by calling FLASH_Init. For other functions, an initialized instance of this data structure should be passed as an argument.

Table 22-34.	flash	config	t	data	structure
--------------	-------	--------	---	------	-----------

Offset (hex)	Size	Field	Description		
0	4	PFlashBlockBase	Base address of the first PFlash block		
4	4	PFlashTotalSize	Size of all combined PFlash blocks		
8	4	PFlashBlockCount	Number of PFlash blocks		
С	4	PFlashSectorSize	Size (in bytes) of sector of PFlash		
10	4	PFlashCallback	Pointer to a callback function used to do extra operations during erasure (for example, service watchdog)		
14	4	PFlashAccessSegmentSize	Size of FAC access segment		
18	4	PFlashAccessSegmentCount	Count of FAC access segment		
1C	4	flashExecuteInRamFunctionIn fo	Info struct of flash execute-in-ram function		
20	4	FlexRAMBlockBase	FlexNVM device: FlexRAM base address non-FlexNVM device: acceleration RAM memory base address		
24	4	FlexRAMTotalSize	FlexNVM device: FlexRAM size non-FlexNVM device: acceleration RAM memory size		
28	4	DFlashBlockBase	FlexNVM device: D-Flash memory (FlexNVM memory) base address non-FlexNVM device: unused		
2C	4	DFlashTotalSize	FlexNVM device: FlexNVM memory total size non-FlexNVM device: unused		
30	4	EEpromTotalSize	FlexNVM device: the size (in bytes) of the EEPROM area that was partitioned from FlexRAM non-FlexNVM device: unused		

Kinetis Flash Driver API

flash_config_t prototype:

```
typedef struct _flash_config
                                              /*!< Base address of the first PFlash block */</pre>
    uint32_t PFlashBlockBase;
                                              /*!< Size of all combined PFlash block. */</pre>
    uint32 t PFlashTotalSize;
    uint32_t PFlashBlockCount;
                                              /*!< Number of PFlash blocks. */
   uint32 t PFlashSectorSize;
                                              /*!< Size in bytes of a sector of PFlash. */
                                              /*!< Callback function for flash API. */</pre>
    flash callback t PFlashCallback;
    uint32_t PFlashAccessSegmentSize;
                                              /*!< Size in bytes of a access segment of
PFlash. */
    uint32 t PFlashAccessSegmentCount;
                                             /*!< Number of PFlash access segments. */</pre>
   uint32_t *flashExecuteInRamFunctionInfo; /*!< Info struct of flash execute-in-ram</pre>
    uint32_t FlexRAMBlockBase;
                                              /*!< For FlexNVM device, this is the base</pre>
address of FlexRAM
                                                   For non-FlexNVM device, this is the base
address of acceleration RAM memory */
                                              /*!< For FlexNVM device, this is the size of
   uint32_t FlexRAMTotalSize;
FlexRAM
                                                   For non-FlexNVM device, this is the size
of acceleration RAM memory */
   uint32_t DFlashBlockBase; /*!< For FlexNVM device, this is the base address of D-Flash
memory (FlexNVM memory);
                                    For non-FlexNVM device, this field is unused */
   uint32_t DFlashTotalSize; /*!< For FlexNVM device, this is total size of the FlexNVM
                                    For non-FlexNVM device, this field is unused */
   uint32_t EEpromTotalSize; /*!< For FlexNVM device, this is the size in byte of EEPROM
area which was partitioned
                                 from FlexRAM;
                                   For non-FlexNVM device, this field is unused */
} flash_config_t;
```

22.4.5 Flash driver API

This section describes each function supported in the flash driver API.

22.4.5.1 FLASH Init

Checks and initializes the flash module for the other flash API functions.

NOTE

FLASH_Init must be always called before calling other API functions.

Prototype:

status_t FLASH_Init(flash_config_t *config);

Table 22-35. Parameters

Parameter	Description
config	Pointer to flash_config_t data structure in memory, to store driver runtime state.

Table 22-36. Possible status response

Value	Constant	Description
4	kStatus_InvalidArgument	Config pointer is NULL.
100	kStatus_FLASH_SizeError	Returned flash is incorrect.
0	kStatus_Success	This function has performed successfully.

Example:

```
flash_config_t flashInstance;
status_t status = FLASH_Init(&flashInstance);
```

22.4.5.2 FLASH_EraseAll

Erases the entire flash array.

Prototype:

status_t FLASH_EraseAll(flash_config_t *config, uint32_t key);

Table 22-37. Parameters

Parameter	Description
	Pointer to flash_config_t data structure in memory, to store driver runtime state.
	Key used to validate erase operation. Must be set to 0x6B65666B.

Table 22-38. Possible status response

Value	Constants	Description
4	kStatus_InvalidArgument	Config pointer is NULL.
103	kStatus_FLASH_AccessError	Command is not available under current mode/ security.
104	kStatus_FLASH_ProtectionViolation	Any region of the program flash memory is protected.
107	kStatus_FLASH_EraseKeyError	Key is incorrect.
0	kStatus_Success	This function has performed successfully.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Kinetis Flash Driver API

Example:

```
status t status = FLASH EraseAll(&flashInstance, kFLASH ApiEraseKey);
```

22.4.5.3 FLASH_EraseAllUnsecure

Erases the entire flash (including protected sectors) and restores flash to unsecured mode.

Prototype:

status_t FLASH_EraseAllUnsecure(flash_config_t *config, uint32_t key);

Table 22-39. Parameters

Parameter	Description
Config	Pointer to flash_config_t data structure in memory, to store driver runtime state.
Key	Key used to validate erase operation. Must be set to 0x6B65666B.

Table 22-40. Possible Status Response

Value	Constant	Description
4	kStatus_InvalidArgument	Config pointer is NULL.
103	kStatus_FLASH_AccessError	Command is not available under current mode/ security.
107	kStatus_FLASH_EraseKeyError	Key is incorrect.
0	kStatus_Success	This function has performed successfully.

Example:

```
status_t status = FLASH_EraseAllUnsecure(&flashInstance, kFLASH_ApiEraseKey);
```

22.4.5.4 FLASH_Erase

Erases expected flash sectors specified by parameters. For Kinetis devices, the minimum erase unit is one sector.

Prototype:

status_t FLASH_Erase(flash_config_t *config, uint32_t start, uint32_t lengthInBytes, uint32_t
key);

Table 22-41. Parameters

Parameters	Description
Config	Pointer to flash_config_t data structure in memory, to store driver runtime state.
Start	The start address of the desired flash memory to be erased.
	The start address does not need to be sector aligned, but must be word-aligned.
lengthInBytes	The length, given in bytes (not words or long words) to be erased. Must be word-aligned.
Key	Key is used to validate erase operation. Must be set to 0x6B65666B.

Table 22-42. Possible status response

Value	Constant	Description
4	kStatus_InvalidArgument	Config pointer is NULL.
100	kStatus_FLASH_AlignmentError	Start or lengthInBytes; is not long word-aligned.
102	kStatus_FLASH_AddressError	The range to be erased is not a valid flash range.
103	kStatus_FLASH_AccessError	Command is not available under current mode/ security.
104	kStatus_FLASH_ProtectionViolation	The selected program flash sector is protected.
107	kStatus_FLASH_EraseKeyError	Key is incorrect.
0	kStatus_Success	This function has performed successfully.

Example:

status_t status = FLASH_Erase (&flashInstance, 0x800, 1024, kFLASH_ApiEraseKey);

22.4.5.5 FLASH_Program

Programs the flash memory with data at locations that are passed in using parameters.

Prototype:

status_t FLASH_Program(flash_config_t *config, uint32_t start, uint32_t *src, uint32_t
lengthInBytes);

Table 22-43. Parameters

Parameter	Description
	Pointer to flash_config_t data structure in memory, to store driver runtime state.

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Table 22-43. Parameters (continued)

Parameter	Description
Start	The start address of the desired flash memory to be erased.
	The start address does not need to be sector-aligned, but the start address must be word-aligned.
src	Pointer to the source buffer of data that is to be programmed into flash.
lengthInBytes	The length in bytes (not words or long words) to be erased; the length must also be word-aligned.

Table 22-44. Possible status response

Value	Constant	Description
4	kStatus_InvalidArgument	Config or src pointers are NULL.
101	kStatus_FLASH_AlignmentError	Start or lengthInBytes is not longword aligned.
102	kStatus_FLASH_AddressError	The range to be programmed is invalid.
103	kStatus_FLASH_AccessError	Command is not available under current mode/ security.
104	kStatus_FLASH_ProtectionViolation	The selected program flash address is protected.
0	kStatus_Success	This function has performed successfully.

Example:

```
uint32_t m_content[] = {0x01234567, 0x89abcdef};
status_t status = FLASH_Program (&flashInstance, 0x800, &m_content[0], sizeof(m_content));
```

NOTE

Before calling flash_program, make sure that the region to be programmed is empty and is not protected.

22.4.5.6 FLASH_GetSecurityState

Retrieves the current flash security status, including the security enabling state and the backdoor key enabling state.

Prototype:

status_t FLASH_GetSecurityState(flash_config_t *config, flash_security_state_t *state);

Table 22-45. Parameters

Parameters	Description
Config	Pointer to flash_config_t data structure in memory, to store driver runtime state.

Table continues on the next page...

509

Table 22-45. Parameters (continued)

Parameters	Description		
State	Pointer to the value returned for the current security status code:		code:
	Table 22-46. Returned value		
	kFLASH_SecurityStateNotSecure	0	Flash is under unsecured mode.
	kFLASH_SecurityStateBackdoorEnabled	1	Flash is under secured mode and Backdoor is enabled.
	kFLASH_SecurityStateBackdoorDisabled	2	Flash is under secured mode and Backdoor is disabled.

Table 22-47. Possible status response

Value	Constant	Description
4	kStatus_InvalidArgument	Config or state pointers are NULL.
0	kStatus_Success	This function has performed successfully.

Example:

```
flash_security_state_t state;
status_t status = FLASH_GetSecurityState (&flashInstance, &state);
```

22.4.5.7 FLASH_SecurityBypass

Allows the user to bypass security with a backdoor key. If the MCU is in a secured state, then the FLASH_SecurityBypass function unsecures the MCU, by comparing the provided backdoor key with keys in the Flash Configuration Field.

Prototype:

status_t FLASH_SecurityBypass(flash_config_t *config, const uint8_t *backdoorKey);

Table 22-48. Parameters

Parameter	Description
	Pointer to flash_config_t data structure in memory, to store driver runtime state.
backdoorKey	Pointer to the user buffer containing the backdoor key.

Table 22-49. Possible status response

Value	Constant	Description
4	kStatus_InvalidArgument	Config or backdoorKey pointers are NULL.
103	kStatus_FLASH_AccessError	The following condition causes this return value:
		An incorrect backdoor key is supplied Backdoor key access has not been enabled.
0	kStatus_Success	This function has performed successfully.

Example:

Assume that the flash range from 0x400 to 0x40c contains the following content after the last reset, which means that the backdoor key is valid and the backdoor key access has been enabled.

0x11 0x22 0x33 0x44 0x55 0x66 0x77 0x88 0xff 0xff 0xff 0xbf

```
uint8_t backdoorKey[] = {0x11, 0x22, 0x33, 0x44, 0x55, 0x66, 0x77, 0x88};
status t status = FLASH SecurityBypass (&flashInstance, & backdoorKey[0]);
```

22.4.5.8 FLASH_VerifyEraseAll

Checks if the entire flash has been erased to the specified read margin level.

To verify if the entire flash has been fully erased (after executing an FLASH_EraseAll), call FLASH_VerifyEraseAll.

Prototype:

status_t FLASH_VerifyEraseAll(flash_config_t *config, flash_margin_value_t margin);

Table 22-50. Parameters

Parameter	Description
Config	Pointer to flash_config_t data structure in memory, to store driver runtime state.
Margin1	Read margin choice: • kFLASH_MarginValueNormal 0 • kFLASH_MarginValueUser 1 • kFLASH_MarginValueFactory 2

Table 22-51. Possible status response

Value	Constant	Description
4	kStatus_InvalidArgument	Config or backdoorKey pointers are NULL.

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Table 22-51. Possible status response (continued)

Value	Constant	Description
103	kStatus_FLASH_AccessError	An invalid margin choice is specified.
105	kStatus_FLASH_CommandFailure	The entire flash is not fully erased.
0	kStatus_Success	This function has performed successfully.

Example:

Assume that flash_erase_all has been successfully executed.

status_t status = flash_verify_erase_all (&flashInstance, kFLASH_MarginValueUser);

NOTE

For the choice of margin, see the FTFA chapter in the reference manual for detailed information.

22.4.5.9 FLASH_VerifyErase

Verifies the erasure of the desired flash area at a specified margin level. This function checks the appropriate number of flash sectors based on the desired start address and length, to see if the flash has been erased at the specified read margin level.

FLASH_VerifyErase is often called after successfully performing the FLASH_Erase API.

Prototype:

status_t FLASH_VerifyErase(flash_config_t *config, uint32_t start, uint32_t lengthInBytes,
flash margin value t margin);

Table 22-52. Parameters

Parameter	Description
Config	Pointer to flash_config_t data structure in memory, to store driver runtime state.
Start	The start address of the desired flash memory to be verified.
lengthInBytes	The length, given in bytes (not words or long words) to be verified.
	Must be word-aligned.
margin	Read margin choice as follows:
	kFLASH_MarginValueNormal 0 kFLASH_MarginValueUser 1 kFLASH_MarginValueFactory 2

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Table 22-53.	Possible status	response
--------------	-----------------	----------

Value	Constant	Description
4	kStatus_InvalidArgument	Config or backdoorKey pointers are NULL.
101	kStatus_FLASH_AlignmentError	Start or lengthInBytes is not longword aligned.
102	kStatus_FLASH_AddressError	The range to be verified is not a valid flash range.
103	kStatus_FlashAccessError	The following situation causes this response: 1. Command is not available under current mode/security 2. An invalid margin code is provided 3. The requested number of bytes is 0 4. The requested sector crosses a flash block boundary
105	kStatus_FLASH_CommandFailure	The flash range to be verified is not fully erased.
0	kStatus_Success	This function has performed successfully.

Example:

Assume that flash region from 0x800 to 0xc00 has been successfully erased.

```
status_t status = FLASH_VerifyErase(&flashInstance, 0x800, 1024, kFLASH_MarginValueUser);
```

NOTE

For the choice of margin, see the FTFA chapter in the reference manual for detailed information.

22.4.5.10 FLASH_VerifyProgram

Verifies the data programmed in the flash memory (using the Flash Program Check Command), and compares it with expected data for a given flash area (as determined by the start address and length).

FLASH_VerifyProgram is often called after successfully doing FLASH_Program().

Prototype:

```
flash_margin_value_t margin,
uint32_t *failedAddress,
uint32 t *failedData);
```

Table 22-54. Parameters

Parameter	Description	
Config	Pointer to flash_config_t data structure in memory, to store driver runtime state.	
Start	The start address of the desired flash memory to be verified.	
LengthInBytes	The length, given in bytes (not words or long-words) to be verified. Must be word-aligned.	
ExpectedData	Pointer to the expected data that is to be verified against.	
Margin	Read margin choice as follows:	
	kFLASH_MarginValueUser 1 kFLASH_MarginValueFactory 2	
FailedAddress	Pointer to returned failing address.	
FailedData	Pointer to return failing data. Some derivatives do not include failed data as part of the FCCOBx registers. In this instance, 0x00s are returned upon failure.	

Table 22-55. Possible status response

Value	Contants	Description
4	kStatus_InvalidArgument	Config or expectedData pointers are NULL.
101	kStatus_FlashAlignmentError	Start or lengthInBytes is not longword-aligned.
102	kStatus_FLASH_AddressError	The range to be verified is invalid.
103	kStatus_FLASH_AccessError	The following situation causes this response:1. Command is not available under current mode/security.2. An invalid margin code is supplied.
105	kStatus_FLASH_CommandFailure	Either of the margin reads does not match the expected data.
0	kStatus_Success	This function has performed successfully.

Example:

Assume that flash region from 0x800 to 0x807 is successfully programmed with:

0x01 0x23 0x45 0x67 0x89 0xab 0xcd 0xef

NOTE

For the choice of margin, see the FTFA chapter in the reference manual for detailed information.

22.4.5.11 FLASH_GetProperty

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Kinetis Flash Driver API

Returns the desired flash property, which includes base address, sector size, and other options.

Prototype:

status_t flash_get_property(flash_driver_t * driver, flash_property_t whichProperty, uint32_t
* value);

Table 22-56. Parameters

Parameter	Description				
Config	Pointer to flash_config_t data structure in memory to store driver runtime state.				
whichProperty	The desired property from the list of properties.	The desired property from the list of properties.			
	Table 22-57. Properties				
	Definition	Value	Description		
	kFLASH_PropertyPflashSectorSize	0	Get Flash Sector size		
	kFLASH_PropertyPflashTotalSize	1	Get total flash size		
	kFLASH_PropertyPflashBlockBaseAddr	4	Get flash base address		
	kFLASH_PropertyPflashFacSupport	5	Get FAC support status		
	kFLASH_PropertyPflashAccessSegmentSize	6	Get FAC segment size		
	kFLASH_PropertyPflashAccessSegmentCount	7	Get FAC segment count		
	kFLASH_PropertyVersion	32	Get version of Flash Driver API		
Value	Pointer to the value returned for the desired flas	sh prope	rty.		

Table 22-58. Possible status response

Value	Constant	Description
4	kStatus_InvalidArgument	Config or value pointers are invalid.
106	kStatus_FLASH_UnknownProperty	Invalid property is supplied.
0	kStatus_Success	This function has performed successfully.

Example:

```
uint32_t propertyValue;
status_t status = FLASH_GetProperty (&flashInstance, kFLASH_PropertyPflashSectorSize, &propertyValue);
```

22.4.5.12 FLASH_ProgramOnce

Programs a certain Program Once Field with the expected data for a given IFR region (as determined by the index and length).

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

- For each Program Once Field, FLASH_ProgramOnce can only allowed to be called once; otherwise, an error code is returned.
- For targets which do not support FLASH_ProgramOnce, the value of the FLASH_ProgramOnce pointer is 0.

Prototype

status_t flash_program_once (flash_driver_t * driver, uint32_t index, uint32_t *src, uint32_t
lengthInBytes);

Table 22-59. Parameters

Parameter	Description		
Config	Pointer to flash_config_t data structure in memory, to store driver runtime state.		
Index	Index for a certain Program Once Field.		
src	Pointer to the source buffer of data that is to be programmed into the Program Once Field.		
Lengthinbytes	The length, in bytes (not words or long words) to be programmed. Must be word-aligned.		

Table 22-60. Possible status response

Value	Constant	Description
4	kStatus_InvalidArgument	Config or src pointers are NULL.
101	kStatus_FLASH_AlignmentError	index or lengthInBytes is invalid.
103	kStatus_FLASH_AddressError	The following situation causes this response:
		 Command is not available under current mode/ security. An invalid index is supplied. The requested Program Once field has already been programmed to a non-FFFF value. The requested sector crosses a flash block boundary.
115	kStatus_FLASH_CommandNotSupported	This function is not supported.
0	kStatus_Success	This function has performed successfully.

Example:

Assume the Program Once Field has not been programmed before.

```
uint32_t expectedData = 0x78563412;
status_t status = FLASH_ProgramOnce(&flashInstance, 0, &expectedData, 4);
```

NOTE

For the choice of index and length, see the FTFA chapter in RM for detailed information.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Kinetis Flash Driver API

22.4.5.13 FLASH_ReadOnce

Reads a certain flash Program Once Field according to parameters passed by index and length.

For targets that do not support FLASH_ReadOnce, the value of the FLASH_ReadOnce pointer is 0.

Prototype:

status_t flash_read_once (flash_driver_t * driver, uint32_t index, uint32_t *dst, uint32_t
lengthInBytes);

Table 22-61. Parameters

Parameter	Description	
Config	Pointer to flash_config_t data structure in memory, to store driver runtime state.	
Index	Index for a certain Program Once Field.	
dst	Pointer to the destination buffer of data that stores data reads from the Program Once Field.	
Lengthinbytes	The length, in bytes (not words or long words) to be read. Must be word-aligned.	

Table 22-62. Possible status response

Value	Constant	Description
4	kStatus_InvalidArgument	Config or dst pointers are NULL.
101	kStatus_FlashAlignmentError	Index or lengthInBytes is invalid.
103	kStatus_FLASH_AddressError	The following situation causes this response: 1. Command is not available under current mode/ security. 2. An invalid index is supplied.
115	kStatus_FLASH_CommandNotSupported	This function is not supported.
0	kStatus_Success	This function has performed successfully.

Example:

```
uint32_t temp;
    status_t status = FLASH_ReadOnce(&flashInstance, 0, &temp, 4);
```

NOTE

For the choice of index and length, see the FTFA chapter in RM for detailed information.

22.4.5.14 FLASH_ReadResource

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Reads certain regions of IFR determined by the start address, length, and option.

For targets that do not support FLASH_ReadResource, the value of the FLASH_ReadResource pointer is 0.

Prototype:

```
status_t FLASH_ReadResource(
    flash_config_t *config, uint32_t start, uint32_t *dst, uint32_t lengthInBytes,
flash read resource option t option);
```

Table 22-63. Parameters

Parameter	Description			
Config	Pointer to flash_config_t data structure in memory, to store driver runtime state.			
Start	Index for a certain Program Once Field.			
dst	Pointer to the destination buffer of data that stores data reads from IFR.			
Lengthinbytes	The length, in bytes (not words or long words), to be read. Must be word-aligned.			
Option	The resource option which indicates the area that needs be read back. • 0 IFR			
	1 Version ID of the flash module			

Table 22-64. Possible status response

Value	Constant	Description
4	kStatus_InvalidArgument	Config or dst pointers are NULL.
101	kStatus_FLASH_AlignmentError	Start, lengthInBytes, or option is invalid.
103	kStatus_FLASH_AccessError	The following situation causes this response:
		 Command is not available under current mode/ security. An invalid index is supplied. An invalid resource option. Address is out-of-rage for the targeted resource. Address is not long word aligned.
115	kStatus_FLASH_CommandNotSupported	This function is not supported.
0	kStatus_Success	This function has performed successfully.

Example:

```
uint32_t temp[256];
status_t status = FLASH_ReadResource(&flashInstance, 0, &temp[0], 256, 0);
```

NOTE

See the FTFA chapter in RM for detailed information regarding the start, length, and option choices.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Peripherals Supported

22.4.5.15 FLASH_SetCallback

Registers (like to write into a list) expected callback functions into the flash driver, for example, like a function that services a watchdog.

Prototype:

status_t FLASH_SetCallback(flash_config_t *config, flash_callback_t callback);

Table 22-65. Parameters

Parameter	Description	
Config	Pointer to flash_config_t data structure in memory, to store driver runtime state.	
Callback	A pointer points to a function that is called during erasure.	
	A use for this function is to service the watchdog during an erase operation.	

Table 22-66. Possible status response

Value	Constant	Description	
4	kStatus_InvalidArgument	Config or dst pointers are NULL.	
115	kStatus_FLASH_CommandNotSupported	This function is not supported.	
0	kStatus_Success	This function has performed successfully.	

Example:

Assume that there is a function.

```
void led_toggle(void).
status t status = FLASH SetCallback(&flashInstance, led toggle);
```

22.5 Peripherals Supported

This section describes the peripherals supported by the Kinetis ROM Bootloader. To use an interface for bootloader communications, the peripheral must be enabled in the BCA, as shown in Table 22-2. If the BCA is invalid (such as all 0xFF bytes), then all peripherals will be enabled by default.

22.5.1 I2C Peripheral

The Kinetis Bootloader in ROM supports loading data into flash via the I2C peripheral, where the I2C peripheral serves as the I2C slave. A 7-bit slave address is used during the transfer.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

519

Customizing an I2C slave address is also supported. This feature is enabled if the Bootloader Configuration Area (BCA) (shown in Table 22-2) is enabled (tag field is filled with 'kcfg') and the i2cSlaveAddress field is filled with a value other than 0xFF. 0x10 is used as the default I2C slave address.

The maximum supported I2C baud rate depends on corresponding clock configuration field in the BCA. Typical supported baud rate is 400 kbps with factory settings. Actual supported baud rate may be lower or higher than 400 kbps, depending on the actual value of the clockFlags and the clockDivider fields.

Because the I2C peripheral serves as an I2C slave device, each transfer should be started by the host, and each outgoing packet should be fetched by the host.

- An incoming packet is sent by the host with a selected I2C slave address and the direction bit is set as write.
- An outgoing packet is read by the host with a selected I2C slave address and the direction bit is set as read.
- 0x00 will be sent as the response to host if the target is busy with processing or preparing data.

The following flow charts demonstrate the communication flow of how the host reads ping packet, ACK and response from the target.

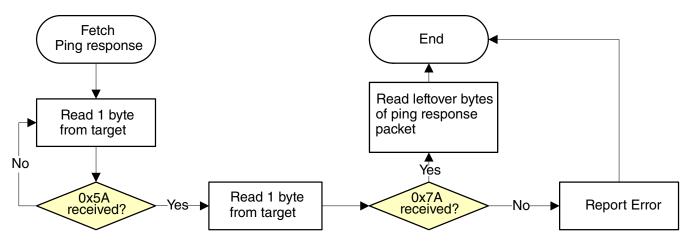


Figure 22-14. Host reads ping response from target via I2C

Peripherals Supported

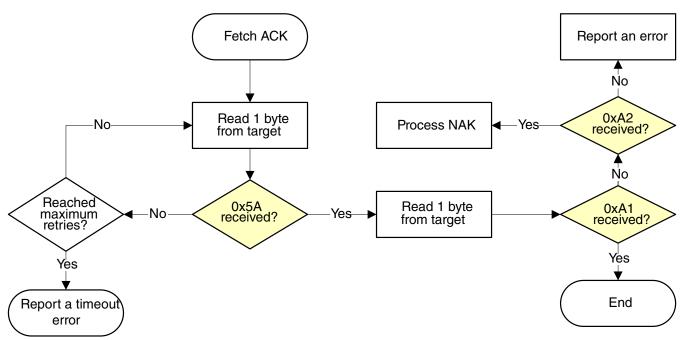


Figure 22-15. Host reads ACK packet from target via I2C

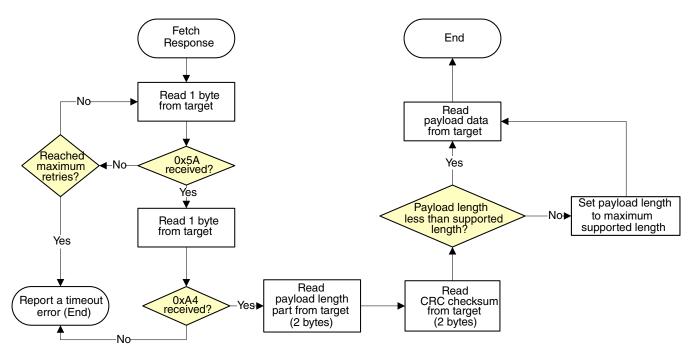


Figure 22-16. Host reads response from target via I2C

22.5.2 SPI Peripheral

The Kinetis Bootloader in ROM supports loading data into flash via the SPI peripheral, where the SPI peripheral serves as a SPI slave.

Maximum supported baud rate of SPI depends on the clock configuration fields in the Bootloader Configuration Area (BCA) shown in Table 22-2. The typical supported baud rate is 400 kbps with the factory settings. The actual baud rate is lower or higher than 400 kbps, depending on the actual value of the clockFlags and clockDivider fields in the BCA.

The SPI peripheral uses the following bus attributes:

- Clock Phase = 1 (Second Edge)
- Clock Polarity = 1 (Active Low)

Because the SPI peripheral in ROM serves as a SPI slave device, each transfer should be started by the host, and each outgoing packet should be fetched by the host.

The transfer on SPI is slightly different from I2C:

- Host will receive 1 byte after it sends out any byte.
- Received bytes should be ignored when host is sending out bytes to target
- Host starts reading bytes by sending 0x00s to target
- The byte 0x00 will be sent as response to host if target is under the following conditions:
 - Processing incoming packet
 - Preparing outgoing data
 - · Received invalid data

The SPI bus configuration is:

- Phase = 1; data is sampled on rising edges
- Polarity = 1; idle is high
- MSB is transmitted first

For any transfer where the target does not have actual data to send, the target (slave) is responsible for ensuring that 0x00 bytes will be returned to the host (master). The host uses framing packets to identify real data and not "dummy" 0x00 bytes (which do not have framing packets).

The following flowcharts demonstrate how the host reads a ping response, an ACK and a command response from target via SPI.

Peripherals Supported

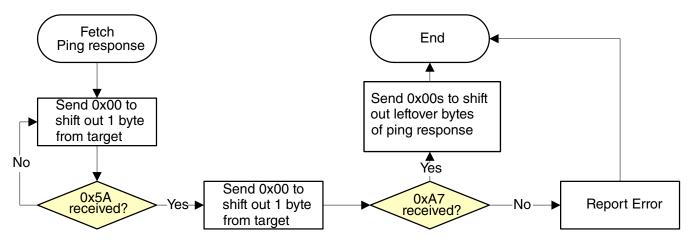


Figure 22-17. Host reads ping packet from target via SPI

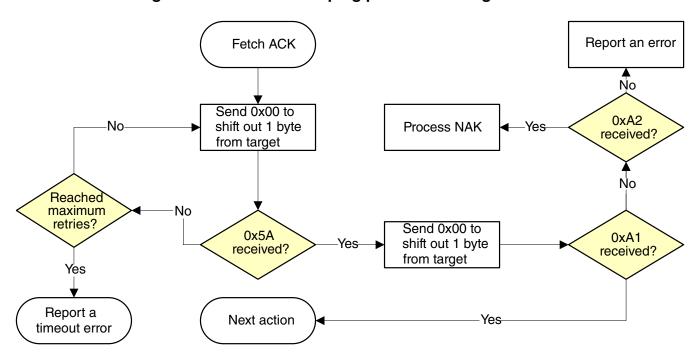


Figure 22-18. Host reads ACK from target via SPI

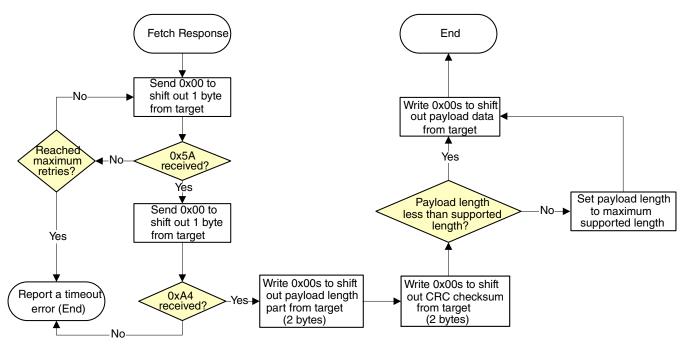


Figure 22-19. Host reads response from target via SPI

22.5.3 UART Peripheral

The Kinetis Bootloader integrates an autobaud detection algorithm for the UART peripheral, thereby providing flexible baud rate choices.

Autobaud feature: If UARTn is used to connect to the bootloader, then the UARTn_RX pin must be kept high and not left floating during the detection phase in order to comply with the autobaud detection algorithm. After the bootloader detects the ping packet $(0x5A\ 0xA6)$ on UARTn_RX, the bootloader firmware executes the autobaud sequence. If the baudrate is successfully detected, then the bootloader will send a ping packet response $[(0x5A\ 0xA7)$, protocol version (4 bytes), protocol version options (2 bytes) and crc16 (2 bytes)] at the detected baudrate. The Kinetis Bootloader then enters a loop, waiting for bootloader commands via the UART peripheral.

NOTE

- The autobaud feature requires a ping packet with a higher accuracy (+/-3%), or the ping packet will be ignored as noise.
- The data bytes of the ping packet must be sent continuously (with no more than 80 ms between bytes) in a fixed UART transmission mode (8-bit data, no parity bit and 1 stop bit). If the bytes of the ping packet are sent one-by-one with more than 80 ms delay between them, then the autobaud

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Peripherals Supported

detection algorithm may calculate an incorrect baud rate. In this case, the autobaud detection state machine should be reset.

Supported baud rates: The baud rate is closely related to the MCU core and system clock frequencies. Typical baud rates supported are 9600, 19200, 38400, 57600, and 115200. Of course, to influence the performance of autobaud detection, the clock configuration in BCA can be changed.

Packet transfer: After autobaud detection succeeds, bootloader communications can take place over the UART peripheral. The following flow charts show:

- How the host detects an ACK from the target
- How the host detects a ping response from the target
- How the host detects a command response from the target

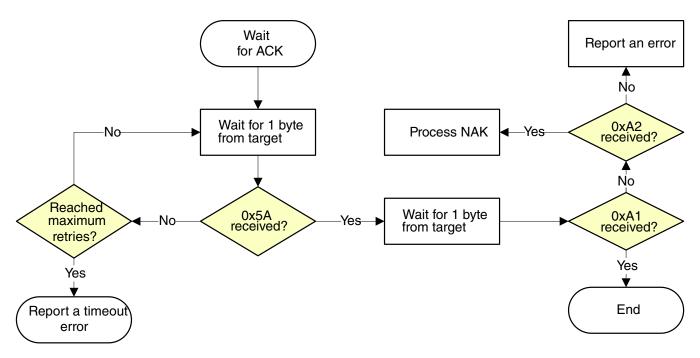


Figure 22-20. Host reads an ACK from target via UART

Chapter 22 Kinetis ROM Bootloader

525

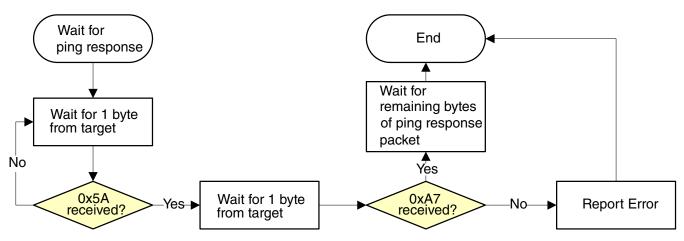


Figure 22-21. Host reads a ping response from target via UART

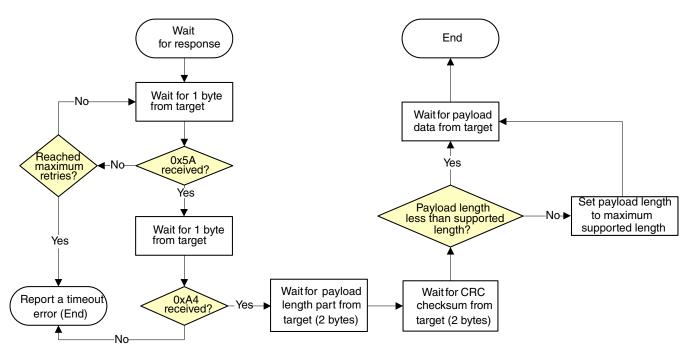


Figure 22-22. Host reads a command response from target via UART

22.6 Get/SetProperty Command Properties

This section lists the properties of the GetProperty and SetProperty commands.

Table 22-67. Properties used by Get/SetProperty Commands, sorted by Value

Property	Writable	Tag Value	Size	Description
CurrentVersion	No	01h	4	Current bootloader version.
AvailablePeripherals	No	02h	4	The set of peripherals supported on this chip.

Table continues on the next page...

Get/SetProperty Command Properties

Table 22-67. Properties used by Get/SetProperty Commands, sorted by Value (continued)

Property	Writable	Tag Value	Size	Description
FlashStartAddress	No	03h	4	Start address of program flash.
FlashSizeInBytes	No	04h	4	Size in bytes of program flash.
FlashSectorSize	No	05h	4	The size in bytes of one sector of program flash.
				This is the minimum erase size.
FlashBlockCount	No	06h	4	Number of blocks in the flash array.
AvailableCommands	No	07h	4	The set of commands supported by the bootloader.
VerifyWrites	Yes	0Ah	4	Controls whether the bootloader will verify writes to flash. VerifyWrites feature is enabled by default.
				0 - No verification is done.
				1 - Enable verification.
MaxPacketSize	No	0Bh	4	Maximum supported packet size for the currently active peripheral interface.
ReservedRegions	No	0Ch	16	List of memory regions reserved by the bootloader. Returned as value pairs (<start-address-of-region>, <end-address-of-region>).</end-address-of-region></start-address-of-region>
				 If HasDataPhase flag is not set, then the Response packet parameter count indicates the number of pairs. If HasDataPhase flag is set, then the second parameter is the number of bytes in the data phase.
ValidateRegions	Yes	0Dh	4	Controls whether the bootloader will validate attempts to write to memory regions (i.e., check if they are reserved before attempting to write). ValidateRegions feature is enabled by default.
				0 - No validation is done
				1 - Enable validation
RAMStartAddress	No	0Eh	4	Start address of RAM segment. The first parameter to GetProperty command identifies the segment. See the device specific memory map for number of RAM segments the device contains.
RAMSizeInBytes	No	0Fh	4	Size in bytes of RAM segment. The first parameter to GetProperty command identifies the segment. See the device specific memory map for number of RAM segments the device contains.
SystemDeviceId	No	10h	4	Value of the Kinetis System Device Identification register.
FlashSecurityState	No	11h	4	Indicates whether Flash security is enabled 0 - Flash security is disabled 1 - Flash security is enabled
UniqueDeviceId	No	12h	16	Unique device identification, value of Kinetis Unique Identification registers (16 for K series devices, 12 for KL series devices)
FacSupport	No	13h	4	FAC (Flash Access Control) support flag 0 - FAC not supported

Table continues on the next page...

Table 22-67. Properties used by Get/SetProperty Commands, sorted by Value (continued)

Property	Writable	Tag Value	Size	Description
				1 - FAC supported
FlashAcessSegmentSize	No	14h	4	The size in bytes of 1 segment of flash
FlashAcessSegmentCount	No	15h		FAC segment count (The count of flash access segments within the flash model.)

22.6.1 Property Definitions

Get/Set property definitions are provided in this section.

22.6.1.1 CurrentVersion Property

The value of this property is a 4-byte structure containing the current version of the bootloader.

Table 22-68. Fields of CurrentVersion property:

Bits	[31:24]	[23:16]	[15:8]	[7:0]
Field	Name = 'K' (0x4B)	Major version	Minor version	Bugfix version

22.6.1.2 AvailablePeripherals Property

The value of this property is a bitfield that lists the peripherals supported by the bootloader and the hardware on which it is running.

Table 22-69. Peripheral bits:

Bit	[31:7]	[6]	[5]	[4]	[3]	[2]	[1]	[0]
Peripheral	Reserved	Reserved	Reserved	Reserved	Reserved	SPI Slave	I2C Slave	UART

If the peripheral is available, then the corresponding bit will be set in the property value. All reserved bits must be set to 0.

22.6.1.3 AvailableCommands Property

This property value is a bitfield with set bits indicating the commands enabled in the bootloader. Only commands that can be sent from the host to the target are listed in the bitfield. Response commands such as GenericResponse are excluded.

The bit number that identifies whether a command is present is the command's tag value minus 1. 1 is subtracted from the command tag because the lowest command tag value is 0x01. To get the bit mask for a given command, use this expression:

 $mask = 1 \ll (tag - 1)$

Table 22-70. Command bits:

Bit	[31: 18]	[17]	[16]	[15]	[14]	[13]	[12]	[11]	[10]	[9]	[8]	[7]	[6]	[5]	[4]	[3]	[2]	[1]	[0]
Command	Reserved	Reserved	Reserved	Reserved	Reserved	Reserved	FlashEraseAllUnsecure	SetProperty	Reset	Reserved	Execute	Reserved	GetProperty	FlashSecurityDisable	Reserved	WriteMemory	Reserved	FlashEraseRegion	FlashEraseAll

22.7 Kinetis Bootloader Status Error Codes

This section describes the status error codes that the Kinetis Bootloader returns to the host.

Table 22-71. Kinetis Bootloader Status Error Codes, sorted by Value

Error Code	Value	Description
kStatus_Success	0	Operation succeeded without error.
kStatus_Fail	1	Operation failed with a generic error.
kStatus_ReadOnly	2	Requested value cannot be changed because it is read-only.
kStatus_OutOfRange	3	Requested value is out of range.
kStatus_InvalidArgument	4	The requested command's argument is undefined.
kStatus_Timeout	5	A timeout occurred.

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Table 22-71. Kinetis Bootloader Status Error Codes, sorted by Value (continued)

Error Code	Value	Description
kStatus_FlashSizeError	100	Not used.
kStatus_FlashAlignmentError	101	Address or length does not meet required alignment.
kStatus_FlashAddressError	102	Address or length is outside addressable memory.
kStatus_FlashAccessError	103	The FTFE_FSTAT[ACCERR] bit is set.
kStatus_FlashProtectionViolation	104	The FTFE_FSTAT[FPVIOL] bit is set.
kStatus_FlashCommandFailure	105	The FTFE_FSTAT[MGSTAT0] bit is set.
kStatus_FlashUnknownProperty	106	Unknown Flash property.
kStatus_FlashEraseKeyError	107	The key provided does not match the programmed flash key.
kStatus_FlashRegionExecuteOnly	108	The area of flash is protected as execute only.
kStatus_I2C_SlaveTxUnderrun	200	I2C Slave TX Underrun error.
kStatus_I2C_SlaveRxOverrun	201	I2C Slave RX Overrun error.
kStatus_I2C_AribtrationLost	202	I2C Arbitration Lost error.
kStatus_SPI_SlaveTxUnderrun	300	SPI Slave TX Underrun error.
kStatus_SPI_SlaveRxOverrun	301	SPI Slave RX Overrun error.
kStatus_SPI_Timeout	302	SPI tranfser timed out.
kStatus_SPI_Busy	303	SPI instance is already busy performing a transfer.
kStatus_SPI_NoTransferInProgress	304	Attempt to abort a transfer when no transfer was in progress.
kStatus_UnknownCommand	10000	The requested command value is undefined.
kStatus_SecurityViolation	10001	Command is disallowed because flash security is enabled.
kStatus_AbortDataPhase	10002	Abort the data phase early.
kStatus_Ping	10003	Internal: received ping during command phase.
kStatusRomLdrSectionOverrun	10100	The loader has finished processing the SB file.
kStatusRomLdrSignature	10101	The signature of the SB file is incorrect.
kStatusRomLdrSectionLength	10102	The section length in chunks is invalid.
kStatusRomLdrUnencryptedOnly	10103	An encrypted SB file has been sent and decryption support is not available.
kStatusRomLdrEOFReached	10104	The end of the SB file has been reached.
kStatusRomLdrChecksum	10105	The checksum of a command tag block is invalid.
kStatusRomLdrCrc32Error	10106	The CRC-32 of the data for a load command is incorrect.
kStatusRomLdrUnknownCommand	10107	An unknown command was found in the SB file.
kStatusRomLdrldNotFound	10108	There was no bootable section found in the SB file.
kStatusRomLdrDataUnderrun	10109	The SB state machine is waiting for more data.
kStatusRomLdrJumpReturned	10110	The function that was jumped to by the SB file has returned.
kStatusRomLdrCallFailed	10111	The call command in the SB file failed.
kStatusRomLdrKeyNotFound	10112	A matching key was not found in the SB file's key dictionary to unencrypt the section.

Table continues on the next page...

Kinetis Bootloader Status Error Codes

Table 22-71. Kinetis Bootloader Status Error Codes, sorted by Value (continued)

Error Code	Value	Description
kStatusRomLdrSecureOnly	10113	The SB file sent is unencrypted and security on the target is enabled.
kStatusRomLdrResetReturned	10114	The SB file reset operation has unexpectedly returned.
kStatusMemoryRangeInvalid	10200	Memory range conflicts with a protected region.
kStatus_UnknownProperty	10300	The requested property value is undefined.
kStatus_ReadOnlyProperty	10301	The requested property value cannot be written.
kStatus_InvalidPropertyValue	10302	The specified property value is invalid.
kStatus_AppCrcCheckPassed	10400	CRC check is valid and passed.
kStatus_AppCrcCheckFailed	10401	CRC check is valid but failed.
kStatus_AppCrcCheckInactive	10402	CRC check is inactive.
kStatus_AppCrcCheckInvalid	10403	CRC check is invalid, because the BCA is invalid or the CRC parameters are unset (all 0xFF bytes).
kStatus_AppCrcCheckOutOfRange	10404	CRC check is valid but addresses are out of range.

Chapter 23 Reset Control Module (RCM)

23.1 Chip-specific information for this module

23.1.1 Instantiation Information

23.1.1.1 Information of RCM on this device

NOTE

The RCM registers can be written only in supervisor mode. Write accesses in user mode are blocked and will result in a bus error. A bus error will generate a hard fault interrupt on this device.

NOTE

High-Voltage Detect (HVD) is not supported on this device. Therefore, HVD related descriptions are not applicable in RCM_SRS[LVD].

23.2 Introduction

Information found here describes the registers of the Reset Control Module (RCM). The RCM implements many of the reset functions for the chip. See the chip's reset chapter for more information.

See AN4503: Power Management for Kinetis and ColdFire+ MCUs for further details on using the RCM.

23.3 Reset memory map and register descriptions

The RCM Memory Map/Register Definition can be found here.

The Reset Control Module (RCM) registers provide reset status information and reset filter control.

NOTE

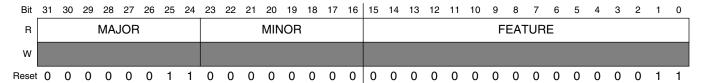
The RCM registers can be written only in supervisor mode. Write accesses in user mode are blocked and will result in a bus error.

RCM memory map

Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page
4007_F000	Version ID Register (RCM_VERID)	32	R	0300_0003h	23.3.1/532
4007_F004	Parameter Register (RCM_PARAM)	32	R	See section	23.3.2/534
4007_F008	System Reset Status Register (RCM_SRS)	32	R	0000_0082h	23.3.3/536
4007_F00C	Reset Pin Control register (RCM_RPC)	32	R/W	0000_0000h	23.3.4/539
4007_F010	Mode Register (RCM_MR)	32	R/W	See section	23.3.5/540
4007_F014	Force Mode Register (RCM_FM)	32	R/W	0000_0000h	23.3.6/541
4007_F018	Sticky System Reset Status Register (RCM_SSRS)	32	R/W	0000_0082h	23.3.7/542
4007_F01C	System Reset Interrupt Enable Register (RCM_SRIE)	32	R/W	0000_0000h	23.3.8/544

23.3.1 Version ID Register (RCM_VERID)

Address: 4007_F000h base + 0h offset = 4007_F000h



RCM_VERID field descriptions

Field	Description
31–24 MAJOR	Major Version Number
	This read only field returns the major version number for the specification.
23–16 MINOR	Minor Version Number

Table continues on the next page...

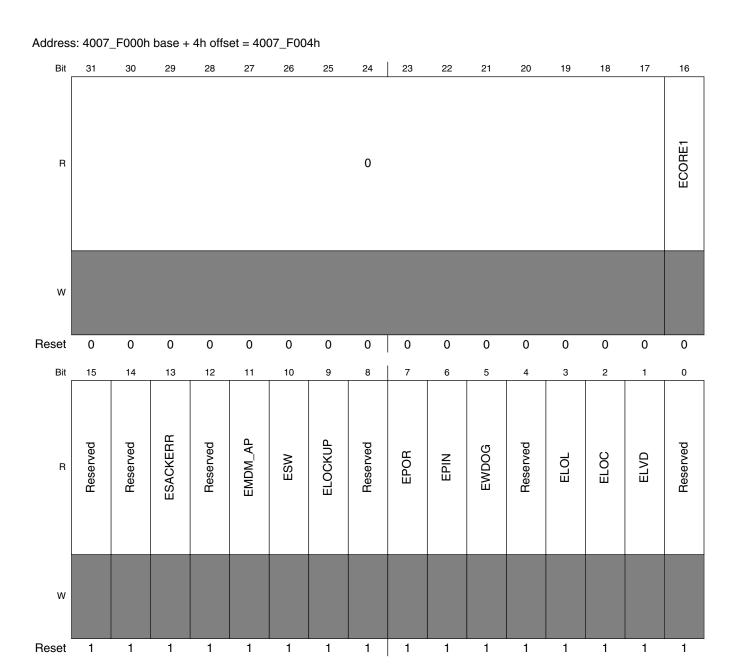
Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Chapter 23 Reset Control Module (RCM)

RCM_VERID field descriptions (continued)

Field	Description
	This read only field returns the minor version number for the specification.
FEATURE	Feature Specification Number
	This read only field returns the feature set number.
	0x0003 Standard feature set.

23.3.2 Parameter Register (RCM_PARAM)



RCM_PARAM field descriptions

Field	Description
	This field is reserved. This read-only field is reserved and always has the value 0.
16 ECORE1	Existence of SRS[CORE1] status indication feature

Table continues on the next page...

RCM_PARAM field descriptions (continued)

Field	Description
	This static bit states whether or not the feature is available on the device.
	0 The feature is not available.
	1 The feature is available.
15 Reserved	This field is reserved.
14	This field is reserved.
Reserved	
13 ESACKERR	Existence of SRS[SACKERR] status indication feature
LONGICETIT	This static bit states whether or not the feature is available on the device.
	0 The feature is not available.
	1 The feature is available.
12 Reserved	This field is reserved.
11	Existence of SRS[MDM_AP] status indication feature
EMDM_AP	This static bit states whether or not the feature is available on the device.
	0 The feature is not available.
	1 The feature is available.
10	Existence of SRS[SW] status indication feature
ESW	This static bit states whether or not the feature is available on the device.
	0 The feature is not available.
	1 The feature is available.
9 ELOCKUP	Existence of SRS[LOCKUP] status indication feature
LLOGIKOI	This static bit states whether or not the feature is available on the device.
	0 The feature is not available.
	1 The feature is available.
8 Reserved	This field is reserved.
7	Existence of SRS[POR] status indication feature
EPOR	This static bit states whether or not the feature is available on the device.
	0 The feature is not available.
	1 The feature is available.
6 EPIN	Existence of SRS[PIN] status indication feature
LEIN	This static bit states whether or not the feature is available on the device.
	0 The feature is not available.
	1 The feature is available.
5 EWDOG	Existence of SRS[WDOG] status indication feature
	This static bit states whether or not the feature is available on the device.

Table continues on the next page...

Reset memory map and register descriptions

RCM_PARAM field descriptions (continued)

Field	Description
	0 The feature is not available.
	1 The feature is available.
4 Reserved	This field is reserved.
3 ELOL	Existence of SRS[LOL] status indication feature
	This static bit states whether or not the feature is available on the device.
	0 The feature is not available.
	1 The feature is available.
2	Existence of SRS[LOC] status indication feature
ELOC	This static bit states whether or not the feature is available on the device.
	0 The feature is not available.
	1 The feature is available.
1 ELVD	Existence of SRS[LVD] status indication feature
	This static bit states whether or not the feature is available on the device.
	0 The feature is not available.
	1 The feature is available.
0	This field is reserved.
Reserved	

23.3.3 System Reset Status Register (RCM_SRS)

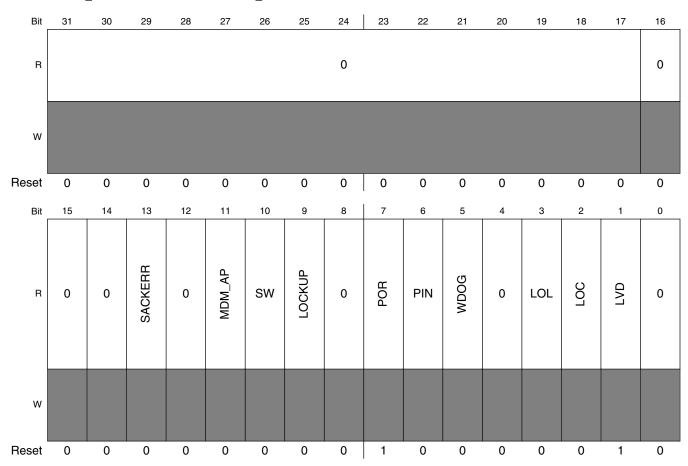
This register includes read-only status flags to indicate the source of the most recent reset. Note that multiple flags can be set if multiple reset events occur at the same time. The reset state of these bits depends on what caused the MCU to reset.

NOTE

The reset value of this register depends on the reset source:

- POR (including LVD) 0x82
- LVD (without POR) 0x02
- Other reset a bit is set if its corresponding reset source caused the reset

Address: 4007_F000h base + 8h offset = 4007_F008h



RCM_SRS field descriptions

Field	Description
31–17 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
16 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
15 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
14 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
13 SACKERR	Stop Acknowledge Error Indicates that after an attempt to enter Stop mode, a reset has been caused by a failure of one or more peripherals to acknowledge within approximately one second to enter stop mode. O Reset not caused by peripheral failure to acknowledge attempt to enter stop mode Reset caused by peripheral failure to acknowledge attempt to enter stop mode
12 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
11 MDM_AP	MDM-AP System Reset Request

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Reset memory map and register descriptions

RCM_SRS field descriptions (continued)

Field	Description
.515	Indicates a reset has been caused by the host debugger system setting of the System Reset Request bit in the MDM-AP Control Register.
	 Reset was not caused by host debugger system setting of the System Reset Request bit Reset was caused by host debugger system setting of the System Reset Request bit
10 SW	Software
	Indicates a reset has been caused by software setting of SYSRESETREQ bit in Application Interrupt and Reset Control Register in the Arm core.
	 Reset not caused by software setting of SYSRESETREQ bit Reset caused by software setting of SYSRESETREQ bit
9 LOCKUP	Core Lockup
LOCKUP	Indicates a reset has been caused by the Arm core indication of a LOCKUP event.
	0 Reset not caused by core LOCKUP event
_	1 Reset caused by core LOCKUP event
8 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
7 POR	Power-On Reset
FOR	Indicates a reset has been caused by the power-on detection logic. Because the internal supply voltage was ramping up at the time, the low-voltage reset (LVD) status bit is also set to indicate that the reset occurred while the internal supply was below the LVD threshold.
	0 Reset not caused by POR
	1 Reset caused by POR
6 PIN	External Reset Pin
	Indicates a reset has been caused by an active-low level on the external RESET (RESET_b) pin.
	0 Reset not caused by external reset pin
	1 Reset caused by external reset pin
5 WDOG	Watchdog
	Indicates a reset has been caused by the watchdog timer timing out. This reset source can be blocked by disabling the watchdog.
	0 Reset not caused by watchdog timeout
	1 Reset caused by watchdog timeout
4 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
3 LOL	Loss-of-Lock Reset
	Indicates a reset has been caused by a loss of lock in the SCG PLL/FLL.
	0 Reset not caused by a loss of lock in the PLL/FLL
	1 Reset caused by a loss of lock in the PLL/FLL
LOC	Loss-of-Clock Reset

Table continues on the next page...

539

RCM_SRS field descriptions (continued)

Field	Description
	Indicates a reset has been caused by a loss of external clock. The SCG SOSC clock monitor must be enabled for a loss of clock to be detected. Refer to the detailed SCG description for information on enabling the clock monitor.
	0 Reset not caused by a loss of external clock.
	1 Reset caused by a loss of external clock.
1 LVD	Low-Voltage Detect Reset or High-Voltage Detect Reset
EVD	If PMC_LVDSC1[LVDRE] is set and the supply drops below the LVD trip voltage, an LVD reset occurs. If PMC_HVDSC1[HVDRE] is set and the supply rises above the HVD trip voltage, an HVD reset occurs. This field is also set by POR.
	0 Reset not caused by LVD trip, HVD trip or POR
	1 Reset caused by LVD trip, HVD trip or POR
0	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.

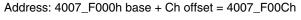
23.3.4 Reset Pin Control register (RCM_RPC)

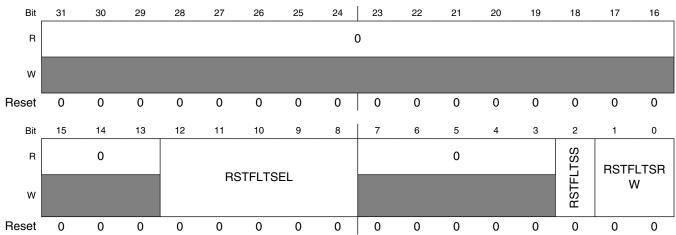
NOTE

This register is reset on Chip POR only, it is unaffected by other reset types.

NOTE

The bus clock filter is reset when disabled or when entering stop mode. The LPO filter is reset when disabled.





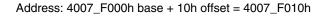
Reset memory map and register descriptions

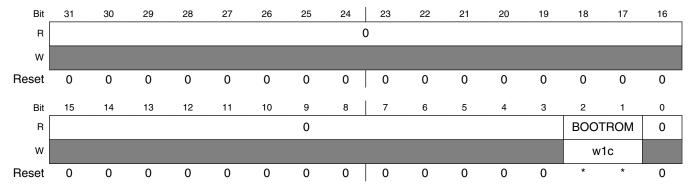
RCM_RPC field descriptions

Field	Description
31–13 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
12–8 RSTFLTSEL	Reset Pin Filter Bus Clock Select Selects the reset pin bus clock filter width: • Transition lengths less than RSTFLTSEL cycles are filtered. • Transition lengths between RSTFLTSEL and (RSTFLTSEL+1) cycles (inclusive) may be filtered. • Transition lengths greater than (RSTFLTSEL+1) cycles are not filtered.
7–3 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
2 RSTFLTSS	Reset Pin Filter Select in Stop Mode Selects how the reset pin filter is enabled in any stop mode. O All filtering disabled LPO clock filter enabled
RSTFLTSRW	Reset Pin Filter Select in Run and Wait Modes Selects how the reset pin filter is enabled in run and wait modes. O All filtering disabled Bus clock filter enabled for normal operation LPO clock filter enabled for normal operation Reserved

23.3.5 Mode Register (RCM_MR)

This register includes status flags to indicate the state of the mode pins during the last Chip Reset.





* Notes:

[•] BOOTROM field: The reset state of this register depends on the boot mode.

RCM_MR field descriptions

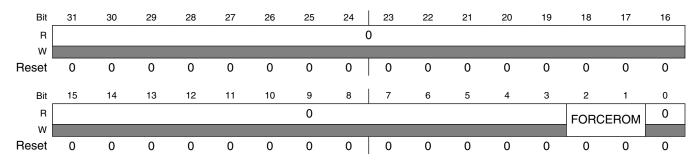
Field	Description				
31–3	This field is reserved.				
Reserved	This read-only field is reserved and always has the value 0.				
2–1	Boot ROM Configuration				
BOOTROM	ndicates the boot source, the boot source remains set until the next System Reset or software can write ogic one to clear the corresponding mode bit.				
	While either bit is set, the NMI input is disabled and the vector table is relocated to the ROM base address at \$1C00_0000. These bits should be cleared by writing logic one before executing any code from either Flash or SRAM.				
	00 Boot from Flash				
	01 Boot from ROM due to BOOTCFG0 pin assertion / Reserved if no Boot pin				
	10 Boot form ROM due to FOPT[7] configuration				
	11 Boot from ROM due to both BOOTCFG0 pin assertion and FOPT[7] configuration				
0	This field is reserved.				
Reserved	This read-only field is reserved and always has the value 0.				

23.3.6 Force Mode Register (RCM_FM)

NOTE

The reset values of the bits in the FORCEROM field are for Chip POR only. They are unaffected by other reset types.

Address: 4007_F000h base + 14h offset = 4007_F014h



RCM_FM field descriptions

Field	Description				
31–3 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.				
2-1 FORCEROM	Force ROM Boot When either bit is set, will force boot from ROM during all subsequent system resets.				
	00 No effect 01 Force boot from ROM with RCM_MR[1] set.				

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

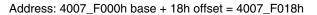
Reset memory map and register descriptions

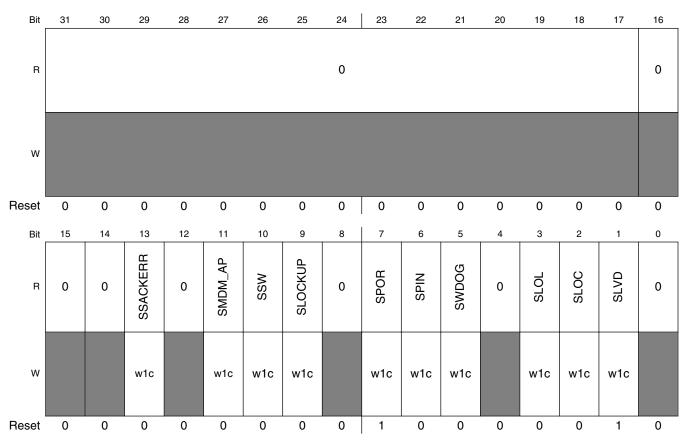
RCM_FM field descriptions (continued)

Field	Description			
	10 Force boot from ROM with RCM_MR[2] set.			
	11 Force boot from ROM with RCM_MR[2:1] set.			
0	This field is reserved.			
Reserved	This read-only field is reserved and always has the value 0.			

23.3.7 Sticky System Reset Status Register (RCM_SSRS)

This register includes status flags to indicate all reset sources since the last POR or LVD that have not been cleared by software. Software can clear the status flags by writing a logic one to a flag.





RCM_SSRS field descriptions

Field	Description					
31–17 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.					
16 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.					
15 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.					
14 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.					
13 SSACKERR	Sticky Stop Acknowledge Error Indicates that after an attempt to enter Stop mode, a reset has been caused by a failure of one or more peripherals to acknowledge within approximately one second to enter stop mode. O Reset not caused by peripheral failure to acknowledge attempt to enter stop mode					
	1 Reset caused by peripheral failure to acknowledge attempt to enter stop mode					
12 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.					
11 SMDM_AP	Sticky MDM-AP System Reset Request Indicates a reset has been caused by the host debugger system setting of the System Reset Request bit in the MDM-AP Control Register. O Reset was not caused by host debugger system setting of the System Reset Request bit Reset was caused by host debugger system setting of the System Reset Request bit					
10 SSW	Sticky Software Indicates a reset has been caused by software setting of SYSRESETREQ bit in Application Interrupt and Reset Control Register in the Arm core. O Reset not caused by software setting of SYSRESETREQ bit Reset caused by software setting of SYSRESETREQ bit					
9 SLOCKUP	Sticky Core Lockup Indicates a reset has been caused by the Arm core indication of a LOCKUP event. O Reset not caused by core LOCKUP event 1 Reset caused by core LOCKUP event					
8 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.					
7 SPOR	Sticky Power-On Reset Indicates a reset has been caused by the power-on detection logic. Because the internal supply voltage was ramping up at the time, the low-voltage reset (LVD) status bit is also set to indicate that the reset occurred while the internal supply was below the LVD threshold. O Reset not caused by POR Reset caused by POR					
6 SPIN	Sticky External Reset Pin Indicates a reset has been caused by an active-low level on the external RESET (RESET_b) pin.					

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Reset memory map and register descriptions

RCM_SSRS field descriptions (continued)

Field	Description				
	Reset not caused by external reset pin				
	1 Reset caused by external reset pin				
5 SWDOG	Sticky Watchdog				
	Indicates a reset has been caused by the watchdog timer timing out. This reset source can be blocked by disabling the watchdog.				
	0 Reset not caused by watchdog timeout				
	1 Reset caused by watchdog timeout				
4	This field is reserved.				
Reserved	This read-only field is reserved and always has the value 0.				
3 SLOL	Sticky Loss-of-Lock Reset				
	Indicates a reset has been caused by a loss of lock in the SCG PLL/FLL. See the SCG description for information on the loss-of-lock event.				
	0 Reset not caused by a loss of lock in the PLL/FLL				
	1 Reset caused by a loss of lock in the PLL/FLL				
2 SLOC	Sticky Loss-of-Clock Reset				
	Indicates a reset has been caused by a loss of external clock. The SCG SOSC clock monitor must be enabled for a loss of clock to be detected. Refer to the detailed SCG description for information on enabling the clock monitor.				
	0 Reset not caused by a loss of external clock.				
	1 Reset caused by a loss of external clock.				
1 SLVD	Sticky Low-Voltage Detect Reset				
	If PMC_LVDSC1[LVDRE] is set and the supply drops below the LVD trip voltage, an LVD reset occurs. This field is also set by POR.				
	0 Reset not caused by LVD trip or POR				
	1 Reset caused by LVD trip or POR				
0	This field is reserved.				
Reserved	This read-only field is reserved and always has the value 0.				

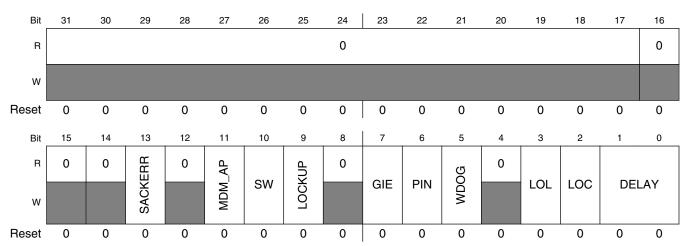
23.3.8 System Reset Interrupt Enable Register (RCM_SRIE)

This register provides the option to delay the assertion of a system reset for a period of time (DELAY field) while an interrupt is generated. When an interrupt for a reset source is enabled, software has time to perform a graceful shutdown. A Chip POR source cannot be delayed by this feature. The SRS updates only after the system reset occurs.

NOTE

This register is reset on Chip POR only, it is unaffected by other reset types.

Address: 4007_F000h base + 1Ch offset = 4007_F01Ch



RCM_SRIE field descriptions

Field	Description
31–17 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
16 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
15 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
14 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
13 SACKERR	Stop Acknowledge Error Interrupt 0 Interrupt disabled. 1 Interrupt enabled.
12 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
11 MDM_AP	MDM-AP System Reset Request 0 Interrupt disabled. 1 Interrupt enabled.
10 SW	Software Interrupt 0 Interrupt disabled. 1 Interrupt enabled.
9 LOCKUP	Core Lockup Interrupt
	NOTE: The LOCKUP bit is useful only in devices with more than one core processor.Interrupt disabled.Interrupt enabled.
8 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
7 GIE	Global Interrupt Enable

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Reset memory map and register descriptions

RCM_SRIE field descriptions (continued)

Field	Description				
	 All interrupt sources disabled. All interrupt sources enabled. Note that the individual interrupt-enable bits still need to be set to generate interrupts. 				
6 PIN	External Reset Pin Interrupt 0 Reset not caused by external reset pin 1 Reset caused by external reset pin				
5 WDOG	Watchdog Interrupt O Interrupt disabled. 1 Interrupt enabled.				
4 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.				
3 LOL	Loss-of-Lock Interrupt 0 Interrupt disabled. 1 Interrupt enabled.				
2 LOC	Loss-of-Clock Interrupt 0 Interrupt disabled. 1 Interrupt enabled.				
DELAY	Reset Delay Time Configures the maximum reset delay time from when the interrupt is asserted and the system reset occurs.				
	 10 LPO cycles 34 LPO cycles 130 LPO cycles 514 LPO cycles 				

Chapter 24 Power Management

24.1 Introduction

This chapter describes the various chip power modes and functionality of the individual modules in these modes. Following stated are general power modes, which are supported additionally by certain clocking mode options. Clock gating technique is used for general power modes and for the additional clocking mode options.

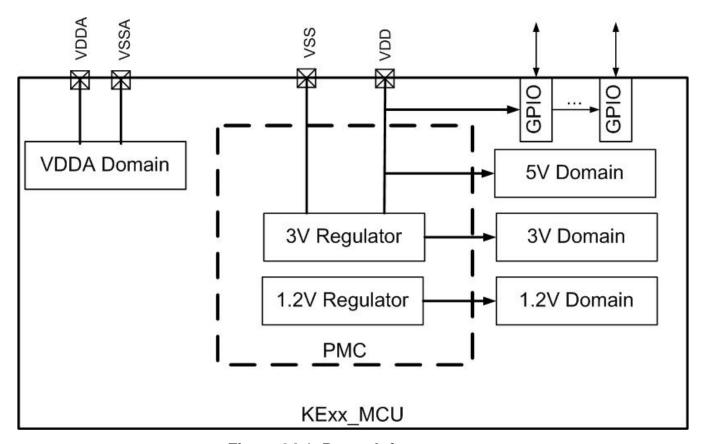


Figure 24-1. Power Infrastructure

24.2 Power Modes Description

The power management controller (PMC) provides multiple power options to allow the user to optimize power consumption for the level of functionality needed.

Depending on the stop requirements of the user application, a variety of stop modes are available that provide state retention, partial power down or full power down of certain logic and/or memory. I/O states are held in all modes of operation. The following table compares the various power modes available.

For Run and VLPR mode there is a corresponding wait and stop mode. Wait modes are similar to ARM sleep modes. Stop modes (VLPS, STOP) are similar to ARM sleep deep mode. The Very Low Power Run (VLPR) operating mode can drastically reduce runtime power when the maximum bus frequency is not required to handle the application needs.

The three primary modes of operation are Run, Wait and Stop. The WFI instruction invokes both wait and stop modes for the chip. The primary modes are augmented in a number of ways to provide lower power based on application needs.

Table 24-1. Chip power modes

Chip mode	Description	Core mode	Normal recovery method
Normal Run	Allows maximum performance of chip. Default mode out of reset; on- chip voltage regulator is on.	Run	-
Normal Wait - via WFI	Allows peripherals to function while the core is in sleep mode, reducing power. NVIC remains sensitive to interrupts; peripherals continue to be clocked.	Sleep	Interrupt
Normal Stop - via WFI	Places chip in static state. On-chip voltage regulator is in a low power mode. LVD is off while maintaining LVR and POR protection. NVIC is disabled; AWIC is used to wake up from interrupt; Peripheral clocks are stopped. All SRAM is operating (content retained and I/O state held). ADC and CMP are optional on.	Sleep Deep	Interrupt
VLPR (Very Low Power Run)	On-chip voltage regulator is in a low power mode that supplies only enough power to run the chip at a reduced frequency. Reduced frequency Flash access mode (1 MHz); LVD off; internal oscillator provides a low power 4 MHz source for the core, the bus and the peripheral clocks.	Run	-
VLPW (Very Low Power Wait) -via WFI	Same as VLPR but with the core in sleep mode to further reduce power; NVIC remains sensitive to interrupts (FCLK = ON). On-chip voltage regulator is in a low power mode that supplies only enough power to run the chip at a reduced frequency.	Sleep	Interrupt
VLPS (Very Low Power Stop)-via WFI	Same as Stop mode, but PMC_REGSC register provides options to gate off unused modules and further reduce power in low power mode.	Sleep Deep	Interrupt

24.2.1 Run mode

Run mode is the default mode after reset, and refers to any mode in which CPU execution is possible. Depending on the on-chip regulator settings, Run mode has the following configurations:

- Normal RUN mode The on-chip regulator voltage output is normal. The 1.2V domain is powered by 1.2V. This allows the MCU digital modules to operate at a normal frequency.
- Very Low Power RUN mode The on-chip regulator voltage is in Low Power mode. The MCU digital modules should operate at a limited frequency but with much lower power.

Run mode configurations can be selected by configuring SMC_PMCTRL.

The following sections describe optimizing power in Run modes.

24.2.1.1 Clock Gating

To conserve power, the clocks to most modules can be turned off using CGC bit of the peripheral control registers in the PCC module. These bits are cleared after any reset, which disables the clock to the corresponding module. Prior to initializing a module, set the corresponding bit in the PCC peripheral control register to enable the clock. Before turning off the clock, make sure to disable the module. For more details, refer to the clock distribution and PCC chapters.

24.2.1.2 Compute Operation

Compute Operation is an execution or compute-only mode of operation that keeps the CPU enabled with full access to the SRAM and Flash read port, but places all other bus masters and bus slaves into their stop mode. Compute Operation can be enabled in Run mode or VLPR mode.

NOTE

Do not enter any stop mode without first exiting Compute Operation.

Because Compute Operation reuses the stop mode logic (including the staged entry with bus masters disabled before bus slaves), any bus master or bus slave that can remain functional in stop mode also remains functional in Compute Operation, including generation of asynchronous interrupts and DMA requests. When enabling Compute

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Power Modes Description

Operation in Run mode, module functionality for bus masters and slaves is the equivalent of STOP mode. When enabling Compute Operation in VLPR mode, module functionality for bus masters and slaves is the equivalent of VLPS mode. SCG, PMC, SRAM and Flash read port are not affected by Compute Operation, although the Flash register interface is disabled.

During Compute Operation, the AIPS peripheral space is disabled and attempted accesses generate bus errors. The private peripheral bus (PPB) remains accessible during Compute Operation, including the MCM, System Control Space (SCS) (for NVIC), and SysTick. Although access to the GPIO registers is supported, the GPIO port data input registers do not return valid data since clocks are disabled to the Port Control and Interrupt modules. By writing to the GPIO port data output registers, it is possible to control those GPIO ports that are configured as output pins.

Compute Operation is controlled by the CPO register in the MCM, which is only accessible to the CPU. Setting or clearing the CPOREQ bit in the MCM initiates entry or exit into Compute Operation. Compute Operation can also be configured to exit automatically on detection of an interrupt, which is required in order to service most interrupts. Only the core system interrupts (exceptions, including NMI and SysTick) and any edge sensitive interrupts can be serviced without exiting Compute Operation.

When entering Compute Operation, the CPOACK status bit indicates when entry has completed. When exiting Compute Operation in Run mode, the CPOACK status bit negates immediately. When exiting Compute Operation in VLPR mode, the exit is delayed to allow the PMC to handle the change in power consumption. This delay means the CPOACK bit is polled to determine when the AIPS peripheral space can be accessed without generating a bus error.

The DMA wakeup is also supported during Compute Operation and causes the CPOACK status bit to clear and the AIPS peripheral space to be accessible for the duration of the DMA wakeup. At the completion of the DMA wakeup, the device transitions back into Compute Operation.

24.2.2 Wait mode

Wait mode refers to a power modes in which the CPU execution is halted. The core clock is gated off. The system clock continues to operate. Bus clocks, if enabled, continue to operate.

Depending on the on-chip regulator settings, Wait mode has the following configurations:

551

- Normal Wait mode The on-chip regulator voltage output is normal. The 1.2V domain is powered by 1.2V. This allows the MCU digital modules to operate at a normal frequency.
- Very Low Power Wait mode The on-chip regulator voltage is in Low Power mode. The MCU digital modules must operate at a limited frequency but with much lower power.

After the CPU executes the WFI/WFE instruction, VLPW mode is entered when MCU is in VLPR mode and Normal Wait mode is entered when MCU is in Normal Run mode. Run mode configurations can be selected by configuring SMC_PMCTRL.

Clock gating can be used to optimize the power in Wait mode. Any interrupt can be used as a wake up source from the Wait mode. See the "Interrupt vector assignments" table in Interrupts chapter for all the available interrupt sources.

24.2.3 Stop mode

Stop mode refers to power modes in which the CPU and most peripherals are static. The SRAM and all registers are retained. The core clock, system clock, and the bus clock are gated off. NVIC is disabled; AWIC is used to wake up from interrupt. In the Stop mode, some peripherals can remain operational with asynchronous clock and can wake up the MCU as needed.

Stop mode configurations can be selected by configuring SMC_PMCTRL.

In Stop mode, the bus clock is gated as core clock and system clock. This device supports a partial Stop mode that permits peripherals to run with the bus clock.

24.2.3.1 Partial Stop

Partial Stop is a clocking option that can be taken instead of entering Stop mode and is configured in the SMC Stop Control Register (SMC_STOPCTRL). The Stop mode is only partially entered, which leaves some additional functionality alive at the expense of higher power consumption. Partial Stop can be entered from either Run mode or VLP Run mode.

When configured for PSTOP2, only the core and system clocks are gated and the bus clock remains active. The bus masters and bus slaves clocked by the system clock enter Stop mode, but the bus slaves clocked by bus clock remain in Run (or VLP Run) mode. The clock generators in the SCG and the on-chip regulator in the PMC also remain in Run (or VLP Run) mode. Exit from PSTOP2 can be initiated by a reset, an asynchronous

Power Modes Description

interrupt from a bus master or bus slave clocked by the system clock, or a synchronous interrupt from a bus slave clocked by the bus clock. If configured, a DMA request (using the asynchronous DMA wakeup) can also be used to exit Partial Stop for the duration of a DMA transfer before the device is transitioned back into PSTOP2.

Any AWIC interrupt can be used as a wake up source from Stop (normal Stop and VLPS) mode. See Table 24-5 for all the available wake up source. Besides waking up the CPU from Stop mode, the DMA can perform data transfer while retaining the CPU in Low Power mode.

DMA Wakeup 24.2.3.2

The DMA can be configured to wake the device on a DMA request whenever it is placed in Stop mode. The wake-up is configured per DMA channel and is supported in Compute Operation, PSTOP, STOP, and VLPS low power modes.

When a DMA wake-up is detected in PSTOP, STOP or VLPS then the device will initiate a normal exit from the low power mode. This can include restoring the on-chip regulator and internal power switches, enabling the clock generators in the SCG, enabling the system and bus clocks (but not the core clock) and negating the stop mode signal to the bus masters and bus slaves. The only difference is that the CPU will remain in the low power mode with the CPU clock disabled.

During Compute Operation, a DMA wake-up will initiate a normal exit from Compute Operation. This includes enabling the clocks and negating the stop mode signal to the bus masters and bus slaves. The core clock always remains enabled during Compute Operation.

Since the DMA wakeup will enable the clocks and negate the stop mode signals to all bus masters and slaves, software needs to ensure that bus masters and slaves that are not involved with the DMA wake-up and transfer remain in a known state. That can be accomplished by disabling the modules before entry into the low power mode or by setting the Doze enable bit in selected modules.

Once the DMA request that initiated the wake-up negates and the DMA completes the current transfer, the device will transition back to the original low-power mode. This includes requesting all non-CPU bus masters to enter Stop mode and then requesting bus slaves to enter Stop mode. In STOP and VLPS modes, SCG and PMC would then also enter their appropriate modes.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018 552 **NXP Semiconductors**

NOTE

If the requested DMA transfer cannot cause the DMA request to negate, then the device will remain in a higher power state until the low power mode is fully exited.

An enabled DMA wake-up can cause an aborted entry into the low power mode, if the DMA request asserts during the stop mode entry sequence (or reentry if the request asserts during a DMA wake-up) and can cause the SMC to assert its Stop Abort flag. Once the DMA wake-up completes, entry into the low power mode will restart.

An interrupt that occurs during a DMA wake-up will cause an immediate exit from the low power mode (this is optional for Compute Operation) without impacting the DMA transfer.

A DMA wake-up can be generated by either a synchronous DMA request or an asynchronous DMA request. Not all peripherals can generate an asynchronous DMA request in stop modes, although in general if a peripheral can generate synchronous DMA requests and also supports asynchronous interrupts in stop modes, then it can generate an asynchronous DMA request.

24.2.4 Power domains

The following table describe the power domain of this device.

Domain name

5V domain is powered by VDD/VSS directly. It contains GPIO and PMC.

VDDA

Analog domain is powered by VDDA/VSSA. It contains analog modules such as ADC and CMP.

3V 3V domain is powered by the PMC 3V regulator. It contains TSI, OSC, and Flash memory.

1.2V domain is powered by the PMC 1.2V regulator. It contains all digital logics and SRAM.

Table 24-2. Power domain summary

Table 24-3. Module power domain summary

VDD (5V)				
PMC GPIOx (all ports)				
VDDA				
ADCx CMPx				
3V CORE				
TSI		osc		

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Power mode transitions

Table 24-3. Module power domain summary (continued)

Flash Memory				
1.2V				
Cortex-M0+ Core	DMAMUX			
SRAM	EWM			
SCG	WDOG			
PCC	CRC			
AXBS-Lite	FlexIO			
Boot ROM	LPI2Cx			
SIM	LPSPIx			
RCM	LPUARTx			
MCM	LPITx			
МТВ	FTMx			
ВМЕ	PDBx			
AIPS-Lite	LPTMRx			
AWIC	RTC			
MMDVSQ	PORTx			
eDMA	TRGMUXx			

24.2.5 Entering and exiting power modes

The WFI instruction invokes wait and stop modes for the chip. The processor exits the low-power mode via an interrupt. The "Interrupt vector assignments" table in the Interrupts chapter describes interrupt operation and what peripherals can cause interrupts.

NOTE

The WFE instruction can have the side effect of entering a low-power mode, but that is not its intended usage. See ARM documentation for more on the WFE instruction.

24.3 Power mode transitions

The following figure shows the power mode transitions. Any reset always brings the chip back to the normal run state. In run, wait, and stop modes active power regulation is enabled. The VLPx modes offer a lower power operating mode than normal modes. VLPR and VLPW are limited in frequency.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

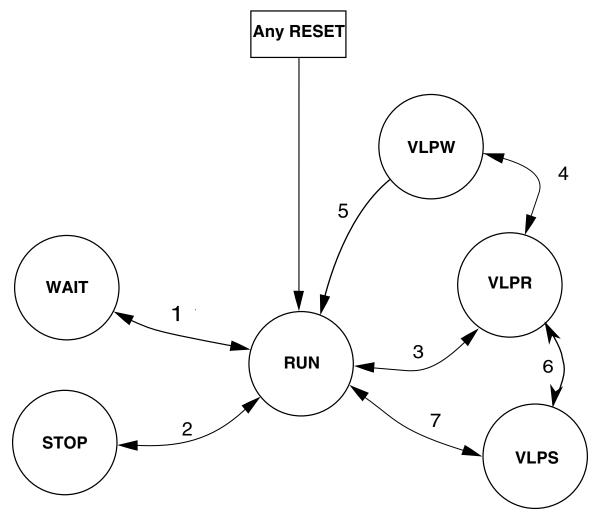


Figure 24-2. Power mode state transition diagram

NOTE

See Table 25-2 in the SMC chapter for more detailed mode transition conditions.

24.4 Power modes shutdown sequencing

When entering stop or other low-power modes, the clocks are shut off in an orderly sequence to safely place the chip in the targeted low-power state. All low-power entry sequences are initiated by the core executing an WFI instruction. The ARM core's outputs, SLEEPDEEP and SLEEPING, trigger entry to the various low-power modes:

- System level wait and VLPW modes equate to: SLEEPING & SLEEPDEEP
- All other low power modes equate to: SLEEPING & SLEEPDEEP

When entering the non-wait modes, the chip performs the following sequence:

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

NXP Semiconductors

555

Module operation in low power modes

- Shuts off Core Clock and System Clock to the ARM Cortex-M core immediately.
- Polls stop acknowledge indications from the non-core crossbar masters (DMA), supporting peripherals (SPI, PIT) and the Flash Controller for indications that System Clocks, Bus Clock and/or Flash Clock need to be left enabled to complete a previously initiated operation, effectively stalling entry to the targeted low power mode. When all acknowledges are detected, System Clock, Bus Clock and Flash Clock are turned off at the same time.
- SCG and Mode Controller shut off clock sources and/or the internal supplies driven from the on-chip regulator as defined for the targeted low power mode.

In wait modes, most of the system clocks are not affected by the low power mode entry. The Core Clock to the ARM Cortex-M core is shut off. Some modules support stop-in-wait functionality and have their clocks disabled under these configurations.

The debugger modules support a transition from stop, wait, VLPS, and VLPW back to a halted state when the debugger is enabled. This transition is initiated by setting the Debug Request bit in MDM-AP control register. As part of this transition, system clocking is reestablished and is equivalent to normal run/VLPR mode clocking configuration.

24.5 Module operation in low power modes

The following table illustrates the functionality of each module while the chip is in each of the low power modes. The standard behavior is shown with some exceptions for Compute Operation (CPO) and Partial Stop2 (PSTOP2).

Debug modules are discussed separately, see "Debug in low power modes" in the Debug chapter. Number ratings (such as 2 MHz and 1 Mbit/s) represent the maximum frequencies or maximum data rates per mode. Also, these terms are used:

- FF = Full functionality. In VLPR and VLPW the system frequency is limited, but if a module does not have a limitation in its functionality, it is still listed as FF.
- Async operation = Fully functional with alternate clock source, provided the selected clock source remains enabled
- static = Module register states and associated memories are retained.
- powered = Memory is powered to retain contents.
- low power = Memory is powered to retain contents in a lower power state

- OFF = Modules are powered off; module is in reset state upon wakeup. For clocks, OFF means disabled.
- wakeup = Modules can serve as a wakeup source for the chip.

Table 24-4. Module operation in low power modes

Modules	VLPR	VLPW	Stop	VLPS		
	Core modules					
NVIC	FF	FF	static	static		
		System modules				
System Mode Controller	FF	FF	FF	FF		
Regulator	low power	low power	low power	low power		
LVD/LVR	disabled (LVR active only)	disabled (LVR active only)	disabled (LVR active only)	disabled (LVR active only)		
POR (Brown-out Detection)	FF	FF	FF	FF		
DMA	FF	FF	Async operation	Async operation		
	Async operation in CPO					
Watchdog	FF	FF	FF	FF		
EWM	FF	static	static	static		
	static in CPO		FF in PSTOP2			
		Clocks				
128 kHz LPO	FF	FF	FF	FF		
System oscillator (SOSC)	SOSC_CLK optional ON	SOSC_CLK optional ON	SOSC_CLK optional ON	SOSC_CLK optional ON		
32 kHz oscillator (OSC32)	Optional ON	Optional ON	Optional ON	Optional ON		
SCG	SOSC, SIRC, FIRC, LPFLL optional ON	SOSC, SIRC, FIRC, LPFLL optional ON	SOSC, SIRC, FIRC optional ON	SOSC, SIRC, FIRC optional ON		
Core clock	4 MHz max	OFF	OFF	OFF		
System clock	4 MHz max OFF in CPO	4 MHz max	OFF	OFF		
Bus clock	4 MHz max	4 MHz max	OFF	OFF		
	OFF in CPO		FF in PSTOP2			
	Mem	nory and memory interfa	aces			
Flash	1 MHz max access - no program/erase	low power	low power	low power		
	No register access in CPO					
System RAM (SRAM_U and SRAM_L)	low power ¹	low power	low power	low power		
FlexMemory	low power ²	low power	low power	low power		
	С	ommunication interface	es			
LPUART	FF	FF	Async operation	Async operation		

Table continues on the next page...

Module operation in low power modes

Table 24-4. Module operation in low power modes (continued)

Modules	VLPR	VLPW	Stop	VLPS	
	Async operation in CPO		FF in PSTOP2		
LPSPI	FF	FF	Async operation	Async operation	
	Async operation in CPO		FF in PSTOP2		
LPI ² C	FF	FF	Async operation	Async operation	
	Async operation in CPO		FF in PSTOP2		
FlexIO	FF	FF	Async operation	Async operation	
	Async operation in CPO		FF in PSTOP2		
		Security			
CRC	FF	FF	static	static	
	static in CPO		FF in PSTOP2		
		Timers			
FTM	FF	FF	static	static	
	static in CPO				
LPIT	FF	FF	Async operation	Async operation	
	static in CPO		FF in PSTOP2		
PWT	FF	FF	static	static	
	static in CPO		FF in PSTOP2		
PDB	FF	FF	static	static	
	static in CPO				
LPTMR	FF	FF	Async operation	Async operation	
			FF in PSTOP2		
RTC	FF	FF	Async operation	Async operation	
	Async operation in CPO		FF in PSTOP2		
		Analog			
12-bit ADC	FF	FF	FF	FF	
	SIRC, FIRC and SOSC clocks only				
CMP ³	LS compare only	LS compare only	LS compare	LS compare only	
			FF in PSTOP2		
	Human-machine interfaces				
GPIO	FF IOPORT write only in	FF	static output, wakeup input	static output, wakeup input	
	CPO CPO		FF in PSTOP2		
TSI	FF	FF	Async operation	Async operation	
	Async operation in CPO		FF in PSTOP2		
	•				

^{1.} SRAM is writable and readable in VLPR mode.

^{2.} FlexRAM enabled as EEPROM is not writable in VLPR and writes are ignored. Read accesses to FlexRAM as EEPROM while in VLPR are allowed. There are no access restrictions for FlexRAM configured as traditional RAM.

^{3.} CMP in stop or VLPS supports low speed external pin to pin or external pin to DAC compares. Windowed, sampled and filtered modes of operation are not available while in stop or VLPS modes.

559

NOTE

- The load current should only change slowly (by peripheral modules being turned on/off, and clock speed being changed) in low power modes.
- Before entering low power modes, the peripheral clock frequencies should be set to desired values, for the modules working in 1.2 V power domain (see Table 24-2, e.g. Boot ROM, FlexIO, LPIT, LPTMR and communication modules).

24.5.1 Peripheral doze

Several peripherals support a Peripheral Doze mode, where a register bit can be used to disable the peripheral for the duration of a low-power mode. The flash memory can also be placed in a low-power state during Peripheral Doze via a register bit in the SIM.

Peripheral Doze is defined to include all of the modes of operation listed below.

- The CPU is in Wait mode.
- The CPU is in Stop mode, including the entry sequence and for the duration of a DMA wakeup.
- The CPU is in Compute Operation, including the entry sequence and for the duration of a DMA wakeup.

Peripheral Doze can therefore be used to disable selected bus masters or slaves for the duration of WAIT or VLPW mode. It can also be used to disable selected bus slaves immediately on entry into any stop mode (or Compute Operation), instead of waiting for the bus masters to acknowledge the entry as part of the stop entry sequence. Finally, it can be used to disable selected bus masters or slaves that should remain inactive during a DMA wakeup.

If the flash memory is not being accessed during WAIT and PSTOP modes, then the Flash Doze mode can be used to reduce power consumption, at the expense of a slightly longer wake-up when executing code and vectors from flash. It can also be used to reduce power consumption during Compute Operation when executing code and vectors from SRAM.

24.6 Low-power wake-up sources

Table 24-5. AWIC Stop and VLPS Wake-up Sources

Wake-up source	Description			
Available system resets	RESET pin, WDOG , loss of clock(LOC) reset and loss of lock (LOL) reset			
Pin interrupts	Port Control Module - Any enabled pin interrupt is capable of waking the system			
ADC	ADC is optional functional with clock source from SIRC or OSC			
CMP	Functional in Stop/VLPS modes with clock source from SIRC or OSC			
DAC	Functional in VLPR/VLPW modes			
LPI2C	Functional in Stop/VLPS modes with clock source from SIRC or OSC			
LPUART	Functional in Stop/VLPS modes with clock source from SIRC or OSC			
LPSPI	Functional in Stop/VLPS modes with clock source from SIRC or OSC			
LPIT	Functional in Stop/VLPS modes with clock source from SIRC or OSC			
FlexIO	Functional in Stop/VLPS modes with clock source from SIRC or OSC			
LPTMR	Functional in Stop/VLPS modes			
RTC	Functional in Stop/VLPS modes			
SCG	Functional in Stop mode			
RCM	Reset wakeup			
TSI	Touch sense wakeup			
NMI	Non-maskable interrupt			

24.7 Power supply supervisor

This device integrates the following power supervisor circuits:

- Power-on reset (POR)
- Low voltage detection (LVD)

561

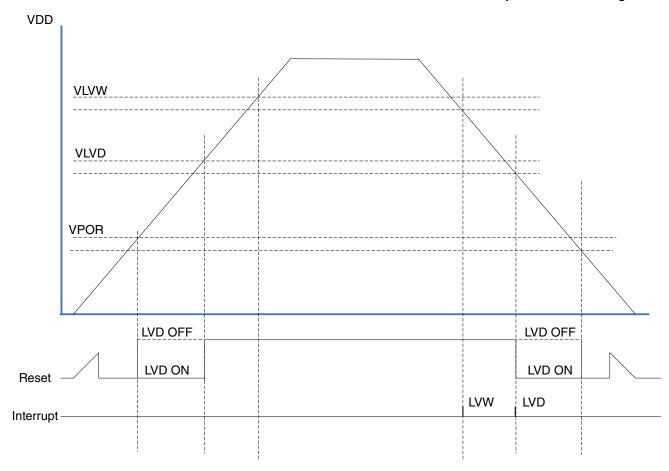


Figure 24-3. Power Supply Supervisor

During power-on, the POR keeps the device under reset until the supply voltage V_{DD} reaches the specified threshold. When V_{DD} is above the V_{POR} limit, the device reset is released and the system can start.

The LVD circuit can be used to monitor the power supply voltage by comparing it to a configurable threshold. User can choose to generate LVD reset or LVW interrupt when power supply voltage drops below the threshold. See PMC chapters for details.

For more details on the POR/LVD reset and the LVW interrupt thresholds, see the electrical characteristics section in the Data Sheet.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Power supply supervisor

Chapter 25 System Mode Controller (SMC)

25.1 Introduction

The System Mode Controller (SMC) is responsible for sequencing the system into and out of all low-power Stop and Run modes.

Specifically, it monitors events to trigger transitions between power modes while controlling the power, clocks, and memories of the system to achieve the power consumption and functionality of that mode.

This chapter describes all the available low-power modes, the sequence followed to enter/exit each mode, and the functionality available while in each of the modes.

The SMC is able to function during even the deepest low power modes.

See AN4503: Power Management for Kinetis MCUs for further details on using the SMC.

25.2 Modes of operation

The Arm CPU has three primary modes of operation:

- Run
- Sleep
- Deep Sleep

The WFI or WFE instruction is used to invoke Sleep and Deep Sleep modes. Run, Wait, and Stop are the common terms used for the primary operating modes of Kinetis microcontrollers.

The following table shows the translation between the Arm CPU modes and the Kinetis MCU power modes.

Modes of operation

564

Arm CPU mode	MCU mode
Sleep	Wait
Deep Sleep	Stop

Accordingly, the Arm CPU documentation refers to sleep and deep sleep, while the Kinetis MCU documentation normally uses wait and stop.

In addition, Kinetis MCUs also augment Stop, Wait, and Run modes in a number of ways. The power management controller (PMC) contains a run and a stop mode regulator. Run regulation is used in normal run, wait and stop modes. Stop mode regulation is used during all very low power and low leakage modes. During stop mode regulation, the bus frequencies are limited in the very low power modes.

The SMC provides the user with multiple power options. The Very Low Power Run (VLPR) mode can drastically reduce run time power when maximum bus frequency is not required to handle the application needs. From Normal Run mode, the Run Mode (RUNM) field can be modified to change the MCU into VLPR mode when limited frequency is sufficient for the application. From VLPR mode, a corresponding wait (VLPW) and stop (VLPS) mode can be entered.

Depending on the needs of the user application, a variety of stop modes are available that allow the state retention, partial power down or full power down of certain logic and/or memory. I/O states are held in all modes of operation. Several registers are used to configure the various modes of operation for the device.

The following table describes the power modes available for the device.

Table 25-1. Power modes

Mode	Description		
RUN	The MCU can be run at full speed and the internal supply is fully regulated, that is, in run regulation. This mode is also referred to as Normal Run mode.		
WAIT	The core clock is gated off. The system clock continues to operate. Bus clocks, if enabled, continue to operate. Run regulation is maintained.		
STOP	The core clock is gated off. System clocks to other masters and bus clocks are gated off after all stop acknowledge signals from supporting peripherals are valid.		
VLPR	The core, system, bus, and flash clock maximum frequencies are restricted in this mode. See the Power Management chapter for details about the maximum allowable frequencies.		
VLPW	The core clock is gated off. The system, bus, and flash clocks continue to operate, although their maximum frequency is restricted. See the Power Management chapter for details on the maximum allowable frequencies.		
VLPS	The core clock is gated off. System clocks to other masters and bus clocks are gated off after all stop acknowledge signals from supporting peripherals are valid.		

NXP Semiconductors

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

25.3 Memory map and register descriptions

Information about the registers related to the system mode controller can be found here.

Different SMC registers reset on different reset types. Each register's description provides details. For more information about the types of reset on this chip, refer to the Reset section details.

NOTE

The SMC registers can be written only in supervisor mode. Write accesses in user mode are blocked and will result in a bus error.

NOTE

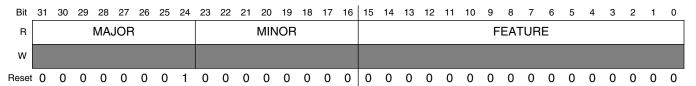
Before executing the WFI instruction, the last register written to must be read back. This ensures that all register writes associated with setting up the low power mode being entered have completed before the MCU enters the low power mode. Failure to do this may result in the low power mode not being entered correctly.

SMC memory map

Absolute address (hex)	Register name		Access	Reset value	Section/ page
4007_E000	SMC Version ID Register (SMC_VERID)	RID) 32 R 0100_0000h 25.3.			
4007_E004	SMC Parameter Register (SMC_PARAM)	32	R See section 25.3.2/566		
4007_E008	Power Mode Protection register (SMC_PMPROT)	32	R/W 0000_0000h 25.3.3/567		25.3.3/567
4007_E00C	Power Mode Control register (SMC_PMCTRL)	32	32 R/W 0000_0000h 25.3.4/569		25.3.4/569
4007_E010	Stop Control Register (SMC_STOPCTRL)	32 R/W 0000_0003h 25.3.5/5		25.3.5/570	
4007_E014	Power Mode Status register (SMC_PMSTAT)	32 R 0000_0001h 25.3.6/57		25.3.6/572	

25.3.1 SMC Version ID Register (SMC_VERID)

Address: 4007_E000h base + 0h offset = 4007_E000h



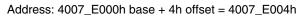
Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

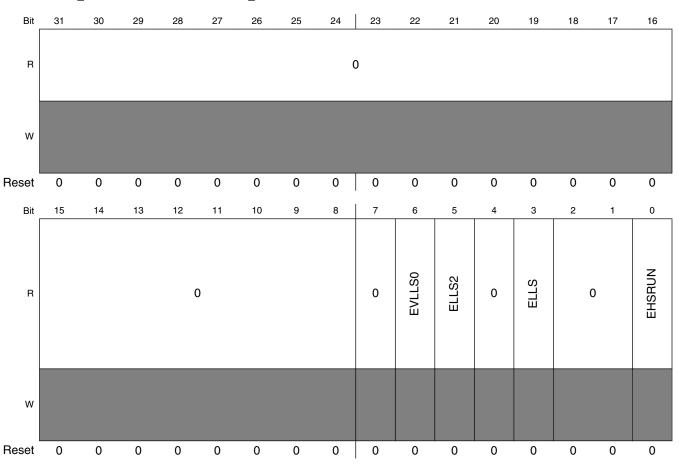
Memory map and register descriptions

SMC_VERID field descriptions

Field	Description		
31–24 MAJOR	Major Version Number		
	This read only field returns the major version number for the module specification.		
23–16 MINOR	Minor Version Number		
	This read only field returns the minor version number for the module specification.		
FEATURE	Feature Specification Number		
	This read only field returns the feature set number.		
	0x0000 Standard features implemented		

25.3.2 SMC Parameter Register (SMC_PARAM)





SMC_PARAM field descriptions

Field	Description			
31–8 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.			
7 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.			
6 EVLLS0	Existence of VLLS0 feature			
	This static bit states whether or not the feature is available on the device.			
	0 The feature is not available.			
	1 The feature is available.			
5 ELLS2	Existence of LLS2 feature			
	This static bit states whether or not the feature is available on the device.			
	0 The feature is not available.			
	1 The feature is available.			
4	This field is reserved.			
Reserved	This read-only field is reserved and always has the value 0.			
3 ELLS	Existence of LLS feature			
ELLS	This static bit states whether or not the feature is available on the device.			
	0 The feature is not available.			
	1 The feature is available.			
2–1	This field is reserved.			
Reserved	This read-only field is reserved and always has the value 0.			
0 FHSRUN	Existence of HSRUN feature			
EHONUN	This static bit states whether or not the feature is available on the device.			
	0 The feature is not available.			
	1 The feature is available.			

25.3.3 Power Mode Protection register (SMC_PMPROT)

This register provides protection for entry into any low-power run or stop mode. The enabling of the low-power run or stop mode occurs by configuring the Power Mode Control register (PMCTRL).

The PMPROT register can be written only once after any system reset.

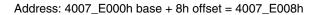
If the MCU is configured for a disallowed or reserved power mode, the MCU remains in its current power mode. For example, if the MCU is in normal RUN mode and AVLP is 0, an attempt to enter VLPR mode using PMCTRL[RUNM] is blocked and PMCTRL[RUNM] remains 00b, indicating the MCU is still in Normal Run mode.

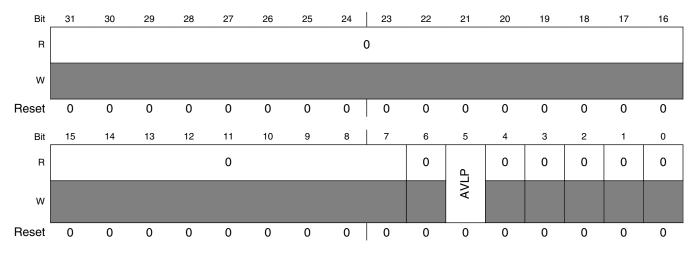
Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Memory map and register descriptions

NOTE

This register is reset on Chip Reset and by reset types that trigger Chip Reset. It is unaffected by reset types that do not trigger Chip Reset. See the Reset section details for more information.





SMC_PMPROT field descriptions

Field	Description
31–7 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
6 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
5 AVLP	Allow Very-Low-Power Modes Provided the appropriate control bits are set up in PMCTRL, this write-once field allows the MCU to enter any very-low-power mode (VLPR, VLPW, and VLPS). 0 VLPR, VLPW, and VLPS are not allowed. 1 VLPR, VLPW, and VLPS are allowed.
4 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
3 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
2 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
1 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
0 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.

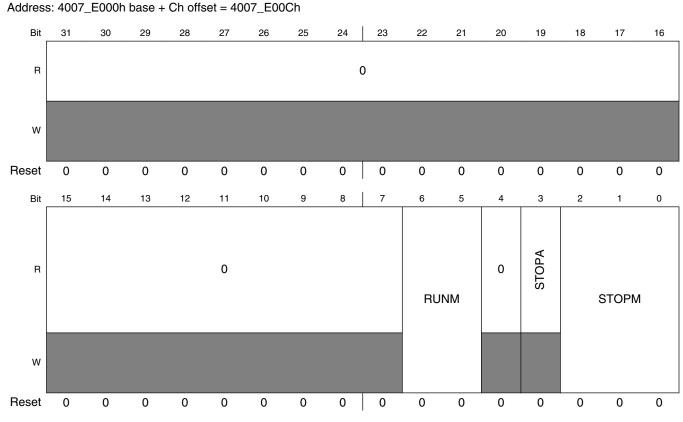
569

25.3.4 Power Mode Control register (SMC_PMCTRL)

The PMCTRL register controls entry into low-power Run and Stop modes, provided that the selected power mode is allowed via an appropriate setting of the protection (PMPROT) register.

NOTE

This register is reset on Chip POR and by reset types that trigger Chip POR. It is unaffected by reset types that do not trigger Chip POR. See the Reset section details for more information.



SMC_PMCTRL field descriptions

Field	Description		
31–7 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.		
RUNM	Run Mode Control When written, causes entry into the selected run mode. Writes to this field are blocked if the protection level has not been enabled using the PMPROT register.		

Table continues on the next page...

Memory map and register descriptions

SMC_PMCTRL field descriptions (continued)

Field	Description			
	NOTE: RUNM may be set to VLPR only when PMSTAT=RUN. After being written to VLPR, RUNM should not be written back to RUN until PMSTAT=VLPR.			
	00 Normal Run mode (RUN)			
	01 Reserved			
	10 Very-Low-Power Run mode (VLPR)			
	11 Reserved			
4	This field is reserved.			
Reserved	This read-only field is reserved and always has the value 0.			
3 STOPA	Stop Aborted			
	When set, this read-only status bit indicates an interrupt occured during the previous stop mode entry sequence, preventing the system from entering that mode. This field is cleared by reset or by hardware at the beginning of any stop mode entry sequence and is set if the sequence was aborted.			
	0 The previous stop mode entry was successful.			
	1 The previous stop mode entry was aborted.			
STOPM	Stop Mode Control			
	When written, controls entry into the selected stop mode when Sleep-Now or Sleep-On-Exit mode is entered with SLEEPDEEP=1. Writes to this field are blocked if the protection level has not been enabled using the PMPROT register. After any system reset, this field is cleared by hardware on any successful write to the PMPROT register.			
	NOTE: When set to STOP, the PSTOPO bits in the STOPCTRL register can be used to select a Partial Stop mode if desired.			
	000 Normal Stop (STOP)			
	001 Reserved			
	010 Very-Low-Power Stop (VLPS)			
	011 Reserved			
	101 Reserved			
	110 Reseved			
	111 Reserved			

25.3.5 Stop Control Register (SMC_STOPCTRL)

The STOPCTRL register provides various control bits allowing the user to fine tune power consumption during the stop mode selected by the STOPM field.

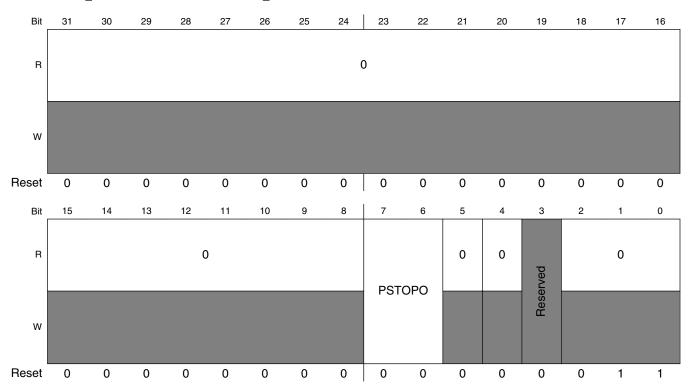
NOTE

This register is reset on Chip POR and by reset types that trigger Chip POR. It is unaffected by reset types that do not trigger Chip POR. See the Reset section details for more information.

570 NXP Semiconductors

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Address: 4007_E000h base + 10h offset = 4007_E010h



SMC_STOPCTRL field descriptions

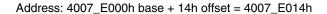
Field	Description			
31–8 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.			
7–6 PSTOPO	Partial Stop Option These bits control whether a Partial Stop mode is entered when STOPM=STOP. When entering a Partial Stop mode from RUN mode, the PMC, SCG and flash remain fully powered, allowing the device to wakeup almost instantaneously at the expense of higher power consumption. In PSTOP2, only system clocks are gated allowing peripherals running on bus clock to remain fully functional. In PSTOP1, both system and bus clocks are gated. O STOP - Normal Stop mode O PSTOP1 - Partial Stop with both system and bus clocks disabled Reserved			
5 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.			
4 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.			
3 Reserved	This field is reserved. This bit is reserved for future expansion. Software should write 0 to this bit to maintain compatibility.			
Reserved	This field is reserved. This read-only field is reserved and always has the value 0.			

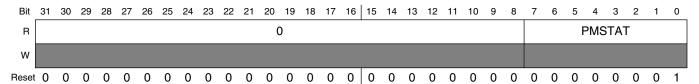
25.3.6 Power Mode Status register (SMC_PMSTAT)

PMSTAT is a read-only, one-hot register which indicates the current power mode of the system.

NOTE

This register is reset on Chip POR and by reset types that trigger Chip POR. It is unaffected by reset types that do not trigger Chip POR. See the Reset section details for more information.





SMC_PMSTAT field descriptions

Field	Description				
31–8	This field is reserved.				
Reserved	This read-only field is reserved and always has the value 0.				
PMSTAT	Power Mode Status				
	NOTE: When debug is enabled, the PMSTAT will not update to STOP or VLPS				
	NOTE: When a PSTOP mode is enabled, the PMSTAT will not update to STOP or VLPS				
	0000_0001 Current power mode is RUN.				
	0000_0010 Current power mode is STOP.				
	0000_0100 Current power mode is VLPR.				
	0_1000 Current power mode is VLPW.				
	0001_0000 Current power mode is VLPS.				
	010_0000 Reserved				
	0100_0000 Reserved				
	1000_0000 Reserved				

25.4 Functional description

25.4.1 Power mode transitions

The following figure shows the power mode state transitions available on the chip. Any reset always brings the MCU back to the normal RUN state.

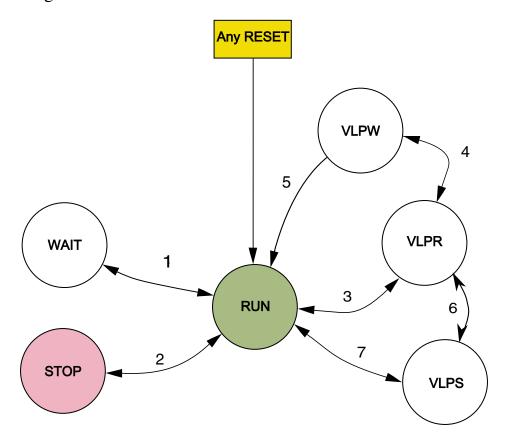


Figure 25-1. Power mode state diagram

The following table defines triggers for the various state transitions shown in the previous figure.

Table 25-2. Power mode transition triggers

Transition #	From	То	Trigger conditions	
1	RUN	WAIT	Sleep-now or sleep-on-exit modes entered with SLEEPDEE clear, controlled in System Control Register in Arm core. See note. ¹	
	WAIT	RUN	Interrupt or Reset	
2	RUN	STOP	PMCTRL[RUNM]=00, PMCTRL[STOPM]=000 ²	
			Sleep-now or sleep-on-exit modes entered with SLEEPDEEP set, which is controlled in System Control Register in Arm core.	

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Functional description

Table 25-2. Power mode transition triggers (continued)

Transition #	From	То	Trigger conditions
			See note. ¹
	STOP	RUN	Interrupt or Reset
3	RUN	VLPR	The core, system, bus and flash clock frequencies and SCG clocking mode are restricted in this mode. See the Power Management chapter for the maximum allowable frequencies and SCG modes supported.
			Set PMPROT[AVLP]=1, PMCTRL[RUNM]=10.
	VLPR	RUN	Set PMCTRL[RUNM]=00 or
			Reset.
4	VLPR	VLPW	Sleep-now or sleep-on-exit modes entered with SLEEPDEEP clear, which is controlled in System Control Register in Arm core.
			See note.1
	VLPW	VLPR	Interrupt
5	VLPW	RUN	Reset
6	VLPR	VLPS	PMCTRL[STOPM]=000 ³ or 010,
			Sleep-now or sleep-on-exit modes entered with SLEEPDEEP set, which is controlled in System Control Register in Arm core.
			See note. ¹
	VLPS	VLPR	Interrupt
			NOTE: If VLPS was entered directly from RUN (transition #7), hardware forces exit back to RUN and does not allow a transition to VLPR.
7	RUN	VLPS	PMPROT[AVLP]=1, PMCTRL[STOPM]=010,
			Sleep-now or sleep-on-exit modes entered with SLEEPDEEP set, which is controlled in System Control Register in Arm core.
			See note. ¹
	VLPS	RUN	Interrupt and VLPS mode was entered directly from RUN or
			Reset

^{1.} If debug is enabled, the core clock remains to support debug.

25.4.2 Power mode entry/exit sequencing

When entering or exiting low-power modes, the system must conform to an orderly sequence to manage transitions safely.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

^{2.} If PMCTRL[STOPM]=000 and STOPCTRL[PSTOPO]=01 or 10, then only a Partial Stop mode is entered instead of STOP

^{3.} If PMCTRL[STOPM]=000 and STOPCTRL[PSTOPO]=00, then VLPS mode is entered instead of STOP. If PMCTRL[STOPM]=000 and STOPCTRL[PSTOPO]=01 or 10, then only a Partial Stop mode is entered instead of VLPS

The SMC manages the system's entry into and exit from all power modes. This diagram illustrates the connections of the SMC with other system components in the chip that are necessary to sequence the system through all power modes.

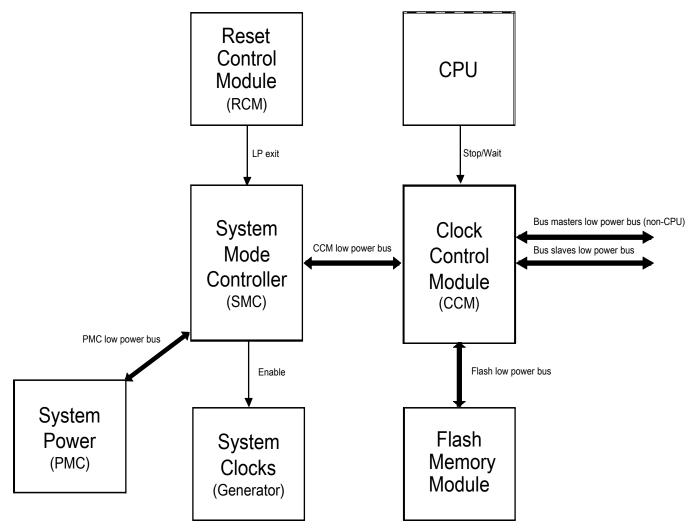


Figure 25-2. Low-power system components and connections

25.4.2.1 Stop mode entry sequence

Entry into a low-power stop mode (Stop, VLPS) is initiated by a CPU executing the WFI instruction. After the instruction is executed, the following sequence occurs:

- 1. The CPU clock is gated off immediately.
- 2. Requests are made to all non-CPU bus masters to enter Stop mode.
- 3. After all masters have acknowledged they are ready to enter Stop mode, requests are made to all bus slaves to enter Stop mode.
- 4. After all slaves have acknowledged they are ready to enter Stop mode, all system and bus clocks are gated off.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Functional description

- 5. Clock generators are disabled in the SCG unless configured to be enabled in Stop mode. See the SCG module information for the programming options.
- 6. The on-chip regulator in the PMC and internal power switches are configured to meet the power consumption goals for the targeted low-power mode.

25.4.2.2 Stop mode exit sequence

Exit from a low-power stop mode is initiated either by a reset or an interrupt event. The following sequence then executes to restore the system to a run mode (RUN or VLPR):

- 1. The on-chip regulator in the PMC and internal power switches are restored.
- 2. Clock generators are enabled in the SCG.
- 3. System and bus clocks are enabled to all masters and slaves.
- 4. The CPU clock is enabled and the CPU begins servicing the reset or interrupt that initiated the exit from the low-power stop mode.

25.4.2.3 Aborted stop mode entry

If an interrupt occurs during a stop entry sequence, the SMC can abort the transition early and return to RUN mode without completely entering the stop mode. An aborted entry is possible only if the interrupt occurs before the PMC begins the transition to stop mode regulation. After this point, the interrupt is ignored until the PMC has completed its transition to stop mode regulation. When an aborted stop mode entry sequence occurs, SMC_PMCTRL[STOPA] is set to 1.

25.4.2.4 Transition to wait modes

For wait modes (WAIT and VLPW), the CPU clock is gated off while all other clocking continues, as in RUN and VLPR mode operation. Some modules that support stop-inwait functionality have their clocks disabled in these configurations.

25.4.2.5 Transition from stop modes to Debug mode

The debugger module supports a transition from STOP, WAIT, VLPS, and VLPW back to a Halted state when the debugger has been enabled. As part of this transition, system clocking is re-established and is equivalent to the normal RUN and VLPR mode clocking configuration.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018 576 NXP Semiconductors

577

25.4.3 Run modes

The run modes supported by this device can be found here.

- Run (RUN)
- Very Low-Power Run (VLPR)

25.4.3.1 RUN mode

This is the normal operating mode for the device.

This mode is selected after any reset. When the Arm processor exits reset, it sets up the stack, program counter (PC), and link register (LR):

- The processor reads the start SP (SP_main) from vector-table offset 0x000
- The processor reads the start PC from vector-table offset 0x004
- LR is set to 0xFFFF_FFFF.

To reduce power in this mode, disable the clocks to unused modules.

25.4.3.2 Very-Low Power Run (VLPR) mode

In VLPR mode, the on-chip voltage regulator is put into a stop mode regulation state. In this state, the regulator is designed to supply enough current to the MCU over a reduced frequency. To further reduce power in this mode, disable the clocks to unused modules using their corresponding clock gating control bits in the PCC's registers.

Before entering this mode, the following conditions must be met:

- All clock monitors in the SCG must be disabled.
- The maximum frequencies of the system, bus, flash, and core are restricted. See the Power Management details about which frequencies are supported.
- Mode protection must be set to allow VLP modes, that is, PMPROT[AVLP] is 1.
- PMCTRL[RUNM] must be set to 10b to enter VLPR.
- Flash programming/erasing is not allowed.

NOTE

Do not increase the clock frequency while in VLPR mode, because the regulator is slow in responding and cannot manage fast load transitions. In addition, do not modify the clock source in the SCG module or any clock divider registers. Module clock enables in the PCC can be set, but not cleared.

Functional description

To reenter Normal Run mode, clear PMCTRL[RUNM]. PMSTAT is a read-only status register that can be used to determine when the system has completed an exit to RUN mode. When PMSTAT=RUN, the system is in run regulation and the MCU can run at full speed in any clock mode. If a higher execution frequency is desired, poll PMSTAT until it is set to RUN when returning from VLPR mode.

Any reset always causes an exit from VLPR and returns the device to RUN mode after the MCU exits its reset flow.

25.4.4 Wait modes

This device contains two different wait modes which are listed here.

- Wait
- Very-Low Power Wait (VLPW)

25.4.4.1 WAIT mode

WAIT mode is entered when the Arm core enters the Sleep-Now or Sleep-On-Exit modes while SLEEPDEEP is cleared. The Arm CPU enters a low-power state in which it is not clocked, but peripherals continue to be clocked provided they are enabled.

When an interrupt request occurs, the CPU exits WAIT mode and resumes processing in RUN mode, beginning with the stacking operations leading to the interrupt service routine.

A system reset causes an exit from WAIT mode, returning the device to normal RUN mode.

25.4.4.2 Very-Low-Power Wait (VLPW) mode

VLPW mode is entered by entering the Sleep-Now or Sleep-On-Exit mode while SLEEPDEEP is cleared and the device is in VLPR mode.

In VLPW, the on-chip voltage regulator remains in its stop regulation state. In this state, the regulator is designed to supply enough current to the device at a reduced frequency. To further reduce power in this mode, disable the clocks to unused modules.

VLPR mode restrictions also apply to VLPW.

When an interrupt from VLPW occurs, the device returns to VLPR mode to execute the interrupt service routine.

579

A system reset causes an exit from VLPW mode, returning the device to normal RUN mode.

25.4.5 Stop modes

This device contains a variety of stop modes to meet your application needs.

The stop modes range from:

• a stopped CPU, with all I/O, logic, and memory states retained, and certain asynchronous mode peripherals operating

to:

• a powered down CPU, with only I/O and a small register file retained, very few asynchronous mode peripherals operating, while the remainder of the MCU is powered down.

The choice of stop mode depends upon the user's application, and how power usage and state retention versus functional needs and recovery time may be traded off.

The various stop modes are selected by setting the appropriate fields in PMPROT and PMCTRL. The selected stop mode is entered during the sleep-now or sleep-on-exit entry with the SLEEPDEEP bit set in the System Control Register in the Arm core.

The available stop modes are:

- Normal Stop (STOP)
- Very-Low Power Stop (VLPS)

25.4.5.1 STOP mode

STOP mode is entered via the sleep-now or sleep-on-exit with the SLEEPDEEP bit set in the System Control Register in the Arm core.

The SCG module can be configured to leave the reference clocks running.

A module capable of providing an asynchronous interrupt to the device takes the device out of STOP mode and returns the device to normal RUN mode. Refer to the device's Power Management chapter for peripheral, I/O, and memory operation in STOP mode. When an interrupt request occurs, the CPU exits STOP mode and resumes processing, beginning with the stacking operations leading to the interrupt service routine.

A system reset will cause an exit from STOP mode, returning the device to normal RUN mode via an MCU reset.

NXP Semiconductors

25.4.5.2 Very-Low-Power Stop (VLPS) mode

The two ways in which VLPS mode can be entered are listed here.

- Entry into stop via the sleep-now or sleep-on-exit with the SLEEPDEEP bit set in the System Control Register in the Arm core while the MCU is in VLPR mode and PMCTRL[STOPM] = 010 or 000.
- Entry into stop via the sleep-now or sleep-on-exit with the SLEEPDEEP bit set in the System Control Register in the Arm core while the MCU is in normal RUN mode and PMCTRL[STOPM] = 010. When VLPS is entered directly from RUN mode, exit to VLPR is disabled by hardware and the system will always exit back to RUN.

In VLPS, the on-chip voltage regulator remains in its stop regulation state as in VLPR.

A module capable of providing an asynchronous interrupt to the device takes the device out of VLPS and returns the device to VLPR mode.

A system reset will also cause a VLPS exit, returning the device to normal RUN mode.

25.4.6 Debug in low power modes

When the MCU is secure, the device disables/limits debugger operation. When the MCU is unsecure, the Arm debugger can assert two power-up request signals:

- System power up, via SYSPWR in the Debug Port Control/Stat register
- Debug power up, via CDBGPWRUPREQ in the Debug Port Control/Stat register

When asserted while in RUN, WAIT, VLPR, or VLPW the mode controller drives a corresponding acknowledge for each signal, that is, both CDBGPWRUPACK and CSYSPWRUPACK. When both requests are asserted, the mode controller handles attempts to enter STOP and VLPS by entering an emulated stop state. In this emulated stop state:

- the regulator is in run regulation,
- the SCG-generated clock source is enabled,
- all system clocks, except the core clock, are disabled,
- the debug module has access to core registers, and
- access to the on-chip peripherals is blocked.

Chapter 26 Power Management Controller (PMC)

26.1 Chip-specific Information for this Module

NOTE

If needed in some case, PMC_REGSC[CLKBIASDIS] should be set manually before entering STOP or VLPS mode. See CLKBIASDIS for more information. In the bitfield description, "RPM" is an alias of Low Power Mode (LPM).

26.2 Introduction

The PMC contains the internal voltage regulator, power on reset (POR) and the low voltage detect (LVD) system.

26.3 Features

The PMC features include:

- Internal voltage regulator offering a variety of power modes
- Active POR providing brown-out detect
- Low voltage reset (LVR)
- Low voltage detect supporting two low voltage trip points and interrupt
- Low power oscillator (LPO) with a typical frequency of 128 kHz

26.4 Modes of Operation

26.4.1 Full Performance Mode (FPM)

For the following Chip Power Modes, the internal voltage regulator is in full performance mode: HSRUN, RUN, WAIT.

26.4.2 Low Power Mode (LPM)

For the following Chip Power Modes, the internal voltage regulator is in low power mode: STOP, VLPR, VLPW, VLPS.

26.5 Low Voltage Detect (LVD) System

NOTE

The low voltage detect system (Low voltage detect flag, Low voltage warning flag and Low voltage detect reset generation) is disabled in low power mode.

This device includes a system to guard against low voltage conditions. This protects memory contents and controls MCU system states during supply voltage variations. The system is comprised of a power-on reset (POR) circuit and a LVD circuit with two trip points. The LVD is disabled upon entering low power mode.

Two flags are available to indicate the status of the low voltage detect system:

- The low voltage detect flag (LVDF) operates in a level sensitive manner. The LVDF bit is set when the supply voltage falls below the trip point (V_{LVD}). The LVDF bit is cleared by writing one to the LVDACK bit, but only if the internal supply has returned above the trip point; otherwise, the LVDF bit remains set.
- The low voltage warning flag (LVWF) operates in a level sensitive manner. The LVWF bit is set when the supply voltage falls below the selected monitor trip point (V_{LVW}). The LVWF bit is cleared by writing one to the LVWACK bit, but only if the internal supply has returned above the trip point; otherwise, the LVWF bit remains set.

26.5.1 Low Voltage Reset (LVR) Operation

If the supply voltage falls below the reset trip point (V_{LVR}) , a system reset will be generated.

If PMC_LVDSC1[LVDRE] is set and the supply voltage falls below V_{LVD} , a system reset will be generated.

583

PMC_LVDSC1[LVDF] will be cleared by system reset, so after recovery PMC_LVDSC1[LVDF] will read zero. Usage of PMC_LVDSC1[LVDF] is intended for LVD interrupt opteration only (for example, PMC_LVDSC1[LVDIE] = 1 and PMC_LVDSC1[LVDRE] = 0).

26.5.2 LVD Interrupt Operation

By configuring the LVD circuit for interrupt operation (LVDIE set), PMC_LVDSC1[LVDF] is set and an LVD interrupt request occurs upon detection of a low voltage condition. The LVDF bit is cleared by writing one to the PMC_LVDSC1[LVDACK] bit, when the supply returns to above the trip point.

26.5.3 Low-voltage warning (LVW) interrupt operation

The LVD system contains a low-voltage warning flag (LVWF) to indicate that the supply voltage is approaching, but is above, the LVD voltage. The LVW also has an interrupt, which is enabled by setting the PMC_LVDSC2[LVWIE] bit. If enabled, an LVW interrupt request occurs when the LVWF is set. LVWF is cleared by writing one to the PMC_LVDSC2[LVWACK] bit, when the supply returns to above the trip point.

26.6 Memory Map and Register Definition

This sections provides the detailed information of all registers for the PMC module.

NOTE

Different portions of PMC registers are reset only by particular reset types. Each register's description provides details.

NOTE

The PMC registers can be written only in supervisor mode. Write accesses in user mode are blocked and will result in a bus error.

PMC memory map

Absolute address (hex)	Register name		Access	Reset value	Section/ page
4007_D000	Low Voltage Detect Status and Control 1 Register (PMC_LVDSC1)	8	R/W	See section	26.6.1/584
4007_D001	Low Voltage Detect Status and Control 2 Register (PMC_LVDSC2)	8	R/W	00h	26.6.2/585
4007_D002	Regulator Status and Control Register (PMC_REGSC)	8	R/W	See section	26.6.3/586
4007_D004	Low Power Oscillator Trim Register (PMC_LPOTRIM)	8	R/W	See section	26.6.4/587

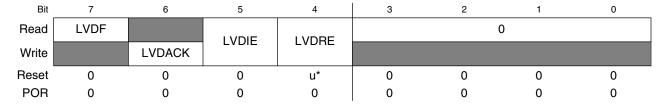
26.6.1 Low Voltage Detect Status and Control 1 Register (PMC_LVDSC1)

This register contains status and control bits to support the low voltage detect function.

NOTE

When the internal voltage regulator is in low power mode, the LVD system is disabled, regardless of the PMC_LVDSC1 settings.

Address: 4007_D000h base + 0h offset = 4007_D000h



^{*} Notes:

PMC_LVDSC1 field descriptions

Field	Description
7	Low Voltage Detect Flag
LVDF	This bit's read-only status bit indicates a low-voltage detect event. The threshold voltage is V _{LVD} .
	0 Low-voltage event not detected
	1 Low-voltage event detected
6	Low Voltage Detect Acknowledge
LVDACK	This write-only bit is used to acknowledge low voltage detection errors. Write 1 to clear LVDF. Read always return 0.
5 LVDIE	Low Voltage Detect Interrupt Enable

Table continues on the next page...

[•] u = Unaffected by reset.

PMC_LVDSC1 field descriptions (continued)

Field	Description
	This bit enables hardware interrupt requests for LVDF.
	0 Hardware interrupt disabled (use polling)
	1 Request a hardware interrupt when LVDF = 1
4	Low Voltage Detect Reset Enable
LVDRE	This bit enables the low voltage detect events to generate a system reset.
	0 No system resets on low voltage detect events.
	1 If the supply voltage falls below V_{LVD} , a system reset will be generated.
Reserved	This field is reserved. This read-only field is reserved and always has the value 0.

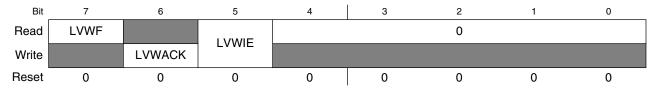
26.6.2 Low Voltage Detect Status and Control 2 Register (PMC_LVDSC2)

This register contains status and control bits to support the low voltage warning (LVW) function.

NOTE

When the internal voltage regulator is in low power mode, the LVD system is disabled regardless of the PMC_LVDSC2 settings.

Address: 4007_D000h base + 1h offset = 4007_D001h



PMC_LVDSC2 field descriptions

Field	Description
7	Low-Voltage Warning Flag
LVWF	This bit read-only status bit indicates a low-voltage detect event. The threshold voltage is V _{LVW} .
	0 Low-voltage warning event not detected
	1 Low-voltage warning event detected
6 LVWACK	Low-Voltage Warning Acknowledge
	This write-only bit is used to acknowledge low voltage warning errors. Write 1 to clear LVWF. Reads always return 0.

Table continues on the next page...

Memory Map and Register Definition

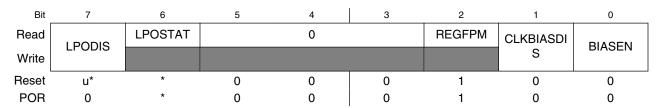
PMC_LVDSC2 field descriptions (continued)

Field	Description
5 LVWIE	Low-Voltage Warning Interrupt Enable
	This bit enables hardware interrupt requests for LVWF.
	0 Hardware interrupt disabled (use polling)
	1 Request a hardware interrupt when LVWF=1
Reserved	This field is reserved. This read-only field is reserved and always has the value 0.

26.6.3 Regulator Status and Control Register (PMC_REGSC)

This register contains general control and status bits for the regulator and the LPO.

Address: 4007_D000h base + 2h offset = 4007_D002h



^{*} Notes:

- u = Unaffected by reset.
- · LPOSTAT field: Reset value is undefined.

PMC_REGSC field descriptions

Field	Description
7	LPO Disable Bit
LPODIS	This bit enables or disable the low power oscillator.
	NOTE: After disabling the LPO a time of 2 LPO clock cycles is required before it is allowed to enable it again. Violating this waiting time of 2 cycles can result in malfunction of the LPO.
	0 Low power oscillator enabled
	1 Low power oscillator disabled
6 LPOSTAT	LPO Status Bit
2. 00	This bit shows the status of the LPO clock to be either in high phase (logic 1) or low phase (logic 0) of the clock period. Software can poll this status bit to measure actual LPO clock frequency and eventually use the LPOTRIM[4:0] register to change the LPO frequency.
	0 Low power oscillator in low phase
	1 Low power oscillator in high phase
5–3	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.

Table continues on the next page...

PMC_REGSC field descriptions (continued)

Field	Description					
2 REGFPM	Regulator in Full Performance Mode Status Bit					
	This read-only bit provides the current status of the internal voltage regulator.					
	0 Regulator is in low power mode or transition to/from					
	1 Regulator is in full performance mode					
1 CLKBIASDIS	Clock Bias Disable Bit					
OLINDIAODIO	This bit disables the bias currents and reference voltages for some clock modules in order to further reduce power consumption in STOP or VLPS mode if all clocks are disabled. The bias currents and reference voltages for LPFLL (if available on device) are always disabled in LPM.					
	Note: Using this bit it must be ensured that respective clock modules are disabled in STOP or VLPS mode. Else severe malfunction of clock modules will happen.					
	0 No effect					
	1 In STOP or VLPS mode the bias currents and reference voltages for the following clock modules are disabled: SIRC, FIRC, PLL. (if available on device)					
0 BIASEN	Bias Enable Bit					
	This bit enables source and well biasing for the core logic in low power mode. In full performance mode this bit has no effect. This is useful to further reduce MCU power consumption in low power mode.					
	0 Biasing disabled, core logic can run in full performance					
	Biasing enabled, core logic is slower and there are restrictions in allowed system clock speed (see Data Sheet for details)					

26.6.4 Low Power Oscillator Trim Register (PMC_LPOTRIM)

This register contains the period trimming bits for the low power oscillator.

Table 26-1. Trimming effect of LPOTRIM[4:0]

LPOTRIM[4:0]	Decimal	Period of LPO clock
10000	-16	lowest
10001	–15	increasing
11110	-2	
11111	-1	
00000	0	typical 128 kHz
00001	+1	increasing
01110	+14	
01111	+15	highest

Memory Map and Register Definition

NOTE

The LPO trimming bits represent signed values. Starting from -16 the period of the LPO clock will increase monotonically (for example, frequency decreases monotonically).

Address: 4007_D000h base + 4h offset = 4007_D004h

Bit	7	6	5	4	3	2	1	0
Read		0				LPOTRIM		
Write								
Reset	0	0	0	*	*	*	*	*
POR	0	0	0	0*	0*	0*	0*	0*

^{*} Notes:

PMC_LPOTRIM field descriptions

Field	Description
7–5 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
LPOTRIM	LPO trimming bits These bits are used for trimming the frequency of the low power oscillator. See the table above for trimming effect.

[·] LPOTRIM field: After POR reset, automatically loaded from Flash Memory IFR after Reset (normal system reset).

Chapter 27 Security

27.1 Introduction

This chapter summarizes all security related features of this device.

27.2 Flash security feature summary

The flash security features supported by this MCU are summarized here.

27.2.1 Flash security byte

Security state can be enabled via programming Flash security byte (FSEC at 0x0000 040E) in the flash configuration field (a 16 Byte region start from 0x0000 0400). User can program the FSEC byte using FTFE flash program phrase commands. The FSEC byte will be loaded into FTFE_FSEC register during boot sequence after chip reset. The FTFE_FSEC register is read-only.

The SEC bit of FSEC byte controls the chip security status. After enabling device security, the debug port (SWD) cannot access the memory resources of the MCU, and ROM boot loader also limited to access flash and not allows reading out flash information via ROM boot loader command.

The flash security byte (FSEC) also allow user to enable the flash backdoor key access feature by configuring the KEYEN bits. When backdoor Key is enabled, the software can unsecure the MCU after presenting the correct backdoor key with Verify Backdoor Access Key command.

The MEEN bit of FSEC byte can be used to disable the mass erase capability from debug port and the FlashEraseAllUnsecure command from ROM bootloader.

Security hardware accelerators

The FSLACC bit of FSEC byte can be used to disable the Freescale/NXP failure analysis. The FSLACC bit permits the user to disable all special or test mode which is only accessible by Freescale/NXP. This feature help user to achieve a highest level to control the access of MCU on chip data.

Please refer to FSEC sections of the FTFE chapter for more details.

From debug port point of view, user can only disable the secure mode by the external mass erase bit from SWD. But if Mass Erase is disabled, the debug port can no longer unsecure the MCU. Please refer to the "Debug and security" section in the Debug chapter for more details.

From ROM bootloader point of view, user can only disable the secure mode by FlashEraseAllUnsecure command or FlashSecurityDisable command. When Mass Erase is disabled, FlashEraseAllUnsecure command can no longer unsecure the MCU. When backdoor key access is disabled, FlashSecurityDisable command cannot be used. Please refer to the ROM chapter for more details.

27.2.2 Flash access protection (FAC)

Flash access controls (FAC) are a configurable memory protection scheme designed to allow end users to utilize software libraries while offering programmable restrictions to these libraries. This allows NXP or third-party vendors to pre-program software libraries into a chip and distribute parts to end customers who can use the pre-programmed software libraries.

Please refer to the Application Note AN5112: Using the Kinetis Flash Execute-Only Access Control Feature, and Flash Access Protection section in the FTFE chapter for more details.

27.3 Security hardware accelerators

27.3.1 CRC

This device contain one cyclic redundancy check (CRC) module which can generates 16/32-bit CRC code for error detection.

591

27.4 General security features

27.4.1 **Unique ID**

This device features 128-bit unique identification number, which programmed in factory and load to SIM register after power on reset. This unique ID permits the software to build a trusted device. This Unique ID generated based on the wafer lot and die series number of factory. The ID is unique for each device and it is accessible from SIM_UIDH, SIM_UIDMH, SIM_UIDML and SIM_UIDL registers. Please refer to the SIM chapter for more details.

27.4.2 Program Once Field

This device also contains 96 bytes Program Once Field in the program flash 0 IFR. User can program specific data into this field by FTFE Program Once command with index $0x00 \sim 0x07$. The data can no longer be erased nor modified after programming. The Program Once Field can be read through Read Once commands. Please refer to Program Once field section in the FTFE chapter for more details.

General security features

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Chapter 28 External Watchdog Monitor (EWM)

28.1 Introduction

For safety, a redundant watchdog system, External Watchdog Monitor (EWM), is designed to monitor external circuits, as well as the MCU software flow. This provides a back-up mechanism to the internal watchdog that resets the MCU's CPU and peripherals.

The watchdog is generally used to monitor the flow and execution of embedded software within an MCU. The watchdog consists of a counter that if allowed to overflow, forces an internal reset (asynchronous) to all on-chip peripherals and optionally assert the RESET pin to reset external devices/circuits. The overflow of the watchdog counter must not occur if the software code works well and services the watchdog to re-start the actual counter.

The EWM differs from the internal watchdog in that it does not reset the MCU's CPU and peripherals. The EWM provides an independent \overline{EWM} _out signal that when asserted resets or places an external circuit into a safe mode. The \overline{EWM} _out signal is asserted upon the EWM counter time-out. An optional external input EWM_in is provided to allow additional control of the assertion of \overline{EWM} _out signal.

28.1.1 Features

Features of EWM module include:

- Independent LPO_CLK clock source
- Programmable time-out period specified in terms of number of EWM LPO_CLK clock cycles.
- Windowed refresh option
 - Provides robust check that program flow is faster than expected.

Introduction

- Programmable window.
- Refresh outside window leads to assertion of EWM_out.
- Robust refresh mechanism
 - Write values of 0xB4 and 0x2C to EWM Refresh Register within 15 (*EWM_refresh_time*) peripheral bus clock cycles.
- One output port, <u>EWM_out</u>, when asserted is used to reset or place the external circuit into safe mode.
- One Input port, EWM_in, allows an external circuit to control the assertion of the EWM_out signal.

28.1.2 Modes of Operation

This section describes the module's operating modes.

28.1.2.1 Stop Mode

When the EWM is in stop mode, the CPU refreshes to the EWM cannot occur. On entry to stop mode, the EWM's counter freezes.

There are two possible ways to exit from Stop mode:

- On exit from stop mode through a reset, the EWM remains disabled.
- On exit from stop mode by an interrupt, the EWM is re-enabled, and the counter continues to be clocked from the same value prior to entry to stop mode.

Note the following if the EWM enters the stop mode during CPU refresh mechanism: At the exit from stop mode by an interrupt, refresh mechanism state machine starts from the previous state which means, if first refresh command is written correctly and EWM enters the stop mode immediately, the next command has to be written within the next 15 (EWM_refresh_time) peripheral bus clocks after exiting from stop mode. User must mask all interrupts prior to executing EWM refresh instructions.

28.1.2.2 Wait Mode

The EWM module treats the stop and wait modes as the same. EWM functionality remains the same in both of these modes.

595

28.1.2.3 **Debug Mode**

Entry to debug mode has no effect on the EWM.

- If the EWM is enabled prior to entry of debug mode, it remains enabled.
- If the EWM is disabled prior to entry of debug mode, it remains disabled.

28.1.3 Block Diagram

This figure shows the EWM block diagram.

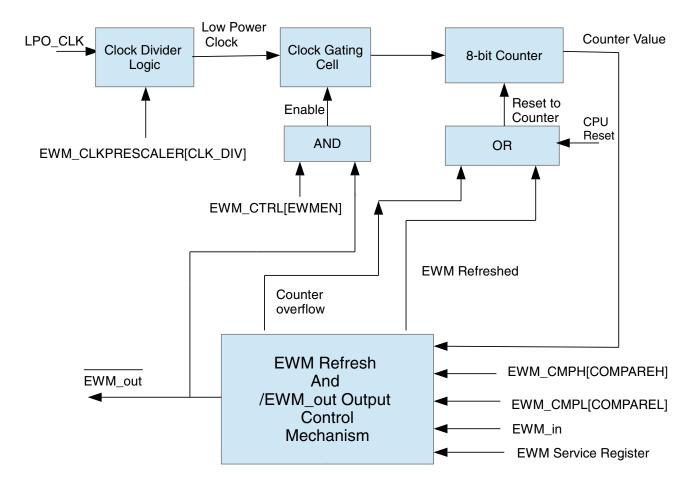


Figure 28-1. EWM Block Diagram

28.2 EWM Signal Descriptions

The EWM has two external signals, as shown in the following table.

Table 28-1. EWM Signal Descriptions

Signal	Description	I/O
EWM_in	EWM input for safety status of external safety circuits. The polarity of EWM_in is programmable using the EWM_CTRL[ASSIN] bit. The default polarity is active-low.	I
EWM_out	EWM reset out signal	0

28.3 Memory Map/Register Definition

This section contains the module memory map and registers.

EWM memory map

Absolute address (hex)	Register name		Access	Reset value	Section/ page
4006_1000	Control Register (EWM_CTRL)		R/W	00h	28.3.1/596
4006_1001	Service Register (EWM_SERV)	8	W (always reads 0)	00h	28.3.2/597
4006_1002	Compare Low Register (EWM_CMPL)		R/W	00h	28.3.3/597
4006_1003	Compare High Register (EWM_CMPH)		R/W	FFh	28.3.4/598
4006_1005	Clock Prescaler Register (EWM_CLKPRESCALER)	8	R/W	00h	28.3.5/599

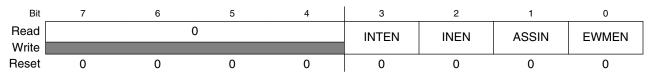
28.3.1 Control Register (EWM CTRL)

The CTRL register is cleared by any reset.

NOTE

INEN, ASSIN and EWMEN bits can be written once after a CPU reset. Modifying these bits more than once, generates a bus transfer error.

Address: 4006_1000h base + 0h offset = 4006_1000h



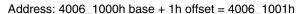
Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

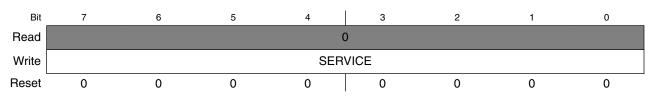
EWM_CTRL field descriptions

Field	Description
7–4 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
3 INTEN	Interrupt Enable. This bit when set and EWM_out is asserted, an interrupt request is generated. To de-assert interrupt request, user should clear this bit by writing 0.
2 INEN	Input Enable. This bit when set, enables the EWM_in port.
1 ASSIN	EWM_in's Assertion State Select. Default assert state of the EWM_in signal is logic zero. Setting the ASSIN bit inverts the assert state of EWM_in signal to a logic one.
0 EWMEN	EWM enable. This bit when set, enables the EWM module. This resets the EWM counter to zero and deasserts the EWM_out signal. This bit when unset, keeps the EWM module disabled. It cannot be re-enabled until a next reset, due to the write-once nature of this bit.

28.3.2 Service Register (EWM_SERV)

The SERV register provides the interface from the CPU to the EWM module. It is write-only and reads of this register return zero.





EWM_SERV field descriptions

Field	Description
SERVICE	The EWM refresh mechanism requires the CPU to write two values to the SERV register: a first data byte of 0xB4, followed by a second data byte of 0x2C. The EWM refresh is invalid if either of the following conditions is true. • The first or second data byte is not written correctly. • The second data byte is not written within a fixed number of peripheral bus cycles of the first data byte. This fixed number of cycles is called EWM_refresh_time.

28.3.3 Compare Low Register (EWM_CMPL)

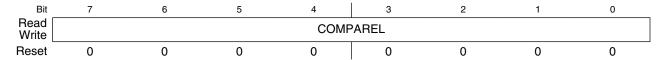
The CMPL register is reset to zero after a CPU reset. This provides no minimum time for the CPU to refresh the EWM counter.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

NOTE

This register can be written only once after a CPU reset. Writing this register more than once generates a bus transfer error.

Address: 4006_1000h base + 2h offset = 4006_1002h



EWM_CMPL field descriptions

Field	Description
	To prevent runaway code from changing this field, software should write to this field after a CPU reset even if the (default) minimum refresh time is required.

28.3.4 Compare High Register (EWM_CMPH)

The CMPH register is reset to 0xFF after a CPU reset. This provides a maximum of 256 clocks time, for the CPU to refresh the EWM counter.

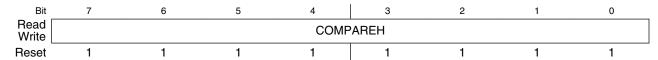
NOTE

This register can be written only once after a CPU reset. Writing this register more than once generates a bus transfer error.

NOTE

The valid values for CMPH are up to 0xFE because the EWM counter never expires when CMPH = 0xFF. The expiration happens only if EWM counter is greater than CMPH.

Address: 4006_1000h base + 3h offset = 4006_1003h



EWM_CMPH field descriptions

	Field	Description
С		To prevent runaway code from changing this field, software should write to this field after a CPU reset even if the (default) maximum refresh time is required.

28.3.5 Clock Prescaler Register (EWM_CLKPRESCALER)

This CLKPRESCALER register is reset to 0x00 after a CPU reset.

NOTE

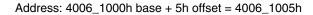
This register can be written only once after a CPU reset. Writing this register more than once generates a bus transfer error.

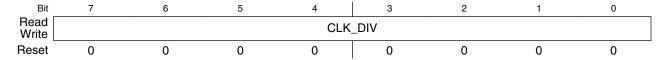
NOTE

Write the required prescaler value before enabling the EWM.

NOTE

The implementation of this register is chip-specific. See the chip-specific information for details.





EWM_CLKPRESCALER field descriptions

Field	Description
CLK_DIV	Selected low power clock source for running the EWM counter can be prescaled as below. • Prescaled clock frequency = low power clock source frequency / (1 + CLK_DIV)

28.4 Functional Description

The following sections describe functional details of the EWM module.

NOTE

When the BUS_CLK is lost, then EWM module doesn't generate the EWM_out signal and no refresh operation is possible

28.4.1 The EWM_out Signal

The EWM_out is a digital output signal used to gate an external circuit (application specific) that controls critical safety functions. For example, the EWM_out could be connected to the high voltage transistors circuits that control an AC motor in a large appliance.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Functional Description

The EWM_out signal remains deasserted when the EWM is being regularly refreshed by the CPU within the programmable refresh window, indicating that the application code is executed as expected.

The EWM_out signal is asserted in any of the following conditions:

- The EWM refresh occurs when the counter value is less than CMPL value.
- The EWM counter value reaches the CMPH value, and no EWM refresh has occurred.
- If functionality of EWM_in pin is enabled and EWM_in pin is asserted while refreshing the EWM.
- After any reset (by the virtue of the external pull-down mechanism on the EWM_out pin)

The EWM_out is asserted after any reset by the virtue of the external pull-down mechanism on the EWM_out signal. Then, to deassert the EWM_out signal, set EWMEN bit in the CTRL register to enable the EWM.

If the EWM_out signal shares its pad with a digital I/O pin, on reset this actual pad defers to being an input signal. The pad state is controlled by the EWM_out signal only after the EWM is enabled by the EWMEN bit in the CTRL register.

Note

EWM_out pad must be in pull down state when EWM functionality is used and when EWM is under Reset.

28.4.2 The EWM_in Signal

The EWM_in is a digital input signal for safety status of external safety circuits, that allows an external circuit to control the assertion of the EWM_out signal. For example, in the application, an external circuit monitors a critical safety function, and if there is fault with safety function, the external circuit can then actively initiate the EWM_out signal that controls the gating circuit.

The EWM_in signal is ignored if the EWM is disabled, or if INEN bit of CTRL register is cleared, as after any reset.

On enabling the EWM (setting the CTRL[EWMEN] bit) and enabling EWM_in functionality (setting the CTRL[INEN] bit), the EWM_in signal must be in the deasserted state prior to the CPU start refreshing the EWM. This ensures that the EWM_out stays in the deasserted state; otherwise, the EWM_out output signal is asserted.

Note

The user must update the CMPH and CMPL registers prior to enabling the EWM. After enabling the EWM, the counter resets to zero, therefore the user shall provide a reasonable time after a power-on reset for the external monitoring circuit to stabilize. The user shall also ensure that the EWM_in pin is deasserted.

28.4.3 **EWM Counter**

It is an 8-bit ripple counter fed from a clock source that is independent of the peripheral bus clock source. As the preferred time-out is between 1 ms and 100 ms the actual clock source should be in the kHz range.

The counter is reset to zero after the CPU reset, or when EWM refresh action completes, or at counter overflow. The counter value is not accessible to the CPU.

EWM Compare Registers 28.4.4

The compare registers CMPL and CMPH are write-once after a CPU reset and cannot be modified until another CPU reset occurs.

The EWM compare registers are used to create a refresh window to refresh the EWM module.

It is illegal to program CMPL and CMPH with same value. In this case, as soon as counter reaches (CMPL + 1), $\overline{\text{EWM}}$ out is asserted.

28.4.5 **EWM Refresh Mechanism**

Other than the initial configuration of the EWM, the CPU can only access the EWM by the EWM Service Register. The CPU must access the EWM service register with correct write of unique data within the windowed time frame as determined by the CMPL and CMPH registers for correct EWM refresh operation. Therefore, three possible conditions can occur:

Table 28-2. EWM Refresh Mechanisms

Condition	Mechanism
An EWM refresh action completes when: CMPL < Counter < CMPH.	The software behaves as expected and the EWM counter is reset to zero. The EWM_out output signal remains in the deasserted state if, during the EWM refresh action, the EWM_in input has been in deasserted state
An EWM refresh action completes when Counter < CMPL	The software refreshes the EWM before the windowed time frame, the counter is reset to zero and the EWM_out output signal is asserted irrespective of the input EWM_in.
Counter value reaches CMPH prior to completion of EWM refresh action.	Software has not refreshed the EWM. The EWM counter is reset to zero and the EWM_out output signal is asserted irrespective of the input EWM_in.

28.4.6 EWM Interrupt

When EWM_out is asserted, an interrupt request is generated to indicate the assertion of the EWM reset out signal. This interrupt is enabled when CTRL[INTEN] is set. Clearing this bit clears the interrupt request but does not affect EWM_out. The EWM_out signal can be deasserted only by forcing a system reset.

28.4.7 Counter clock prescaler

The EWM counter clock source can be prescaled by a clock divider, by programming CLKPRESCALER[CLK_DIV]. This divided clock is used to run the EWM counter.

NOTE

The divided clock used to run the EWM counter must be no more than half the frequency of the bus clock.

28.5 Usage Guide

28.5.1 EWM low-power modes

This table shows the EWM low-power modes and the corresponding chip low-power modes.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

603

Table 28-3. EWM low-power modes

Module mode	Chip mode
Wait	Wait, VLPW
Stop	Stop, VLPS

28.5.2 **EWM_out** pin state in low power modes

During Wait, Stop, and Power Down modes the EWM_out pin preserve its state before entering Wait or Stop mode. When the CPU enters a Run mode from Wait or Stop recovery, the pin resumes its previous state before entering Wait or Stop mode. When the CPU enters Run mode from Power Down, the pin returns to its reset state.

28.5.3 Example code

28.5.3.1 Initializing the EWM

The following code segment shows the initialize sequence of the EWM module. It enables EWM_in pin input with assert state logic zero, enables interrupt when EWM_out is assert. The compare value is also set into CMPL/H register before enabling EWM.

28.5.3.2 Refreshing the EWM

The following code segment shows the refresh write sequence of the EWM module.

```
// Refresh EWM
DisableInterrupts; // disable global interrupt
EWM_SERV= 0xB4; // write the 1st refresh words
EWM_SERV= 0x2C; // write the 2nd refresh words
EnableInterrupts; // enable global interrupt
```

Usage Guide

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

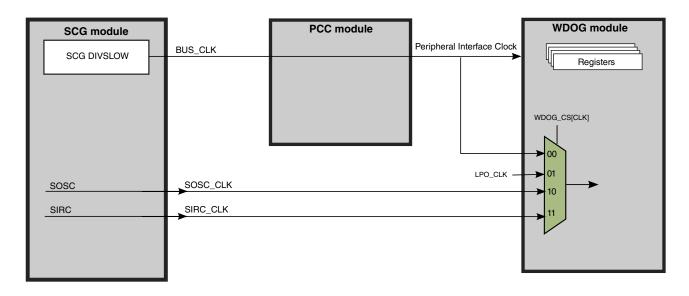
Chapter 29 Watchdog timer (WDOG)

29.1 Chip-specific information for this module

29.1.1 WDOG Clocking Information

The following figure shows the input clock sources available for this module.

Peripheral Clocking - WDOG



29.1.2 WDOG low-power modes

This table shows the WDOG low-power modes and the corresponding chip low-power modes.

Table 29-1. WDOG low-power modes

Module mode	Chip mode
Wait	Wait, VLPW
Stop	Stop, VLPS

29.2 Introduction

The Watchdog Timer (WDOG) module is an independent timer that is available for system use. It provides a safety feature to ensure that software is executing as planned and that the CPU is not stuck in an infinite loop or executing unintended code. If the WDOG module is not serviced (refreshed) within a certain period, it resets the MCU.

29.2.1 Features

606

Features of the WDOG module include:

- Configurable clock source inputs independent from the bus clock
 - Bus clock (slow clock)
 - LPO clock (from PMC)
 - SIRC (8 MHz IRC from SCG)
 - ERCLK (external reference clock from SCG)
- Programmable timeout period
 - Programmable 16-bit timeout value
 - Optional fixed 256 clock prescaler when longer timeout periods are needed
- Robust write sequence for counter refresh
 - Refresh sequence of writing 0xA602 and then 0xB480
- Window mode option for the refresh mechanism
 - Programmable 16-bit window value
 - Provides robust check that program flow is faster than expected
 - Early refresh attempts trigger a reset.
- Optional timeout interrupt to allow post-processing diagnostics

607

- Interrupt request to CPU with interrupt vector for an interrupt service routine (ISR)
- Forced reset occurs 128 bus clocks after the interrupt vector fetch.
- Configuration bits are write-once-after-reset to ensure watchdog configuration cannot be mistakenly altered.
- Robust write sequence for unlocking write-once configuration bits
 - Unlock sequence of writing 0xC520 and then 0xD928 for allowing updates to write-once configuration bits
 - Software must make updates within 128 bus clocks after unlocking and before WDOG closing unlock window.

29.2.2 Block diagram

The following figure shows a block diagram of the WDOG module.

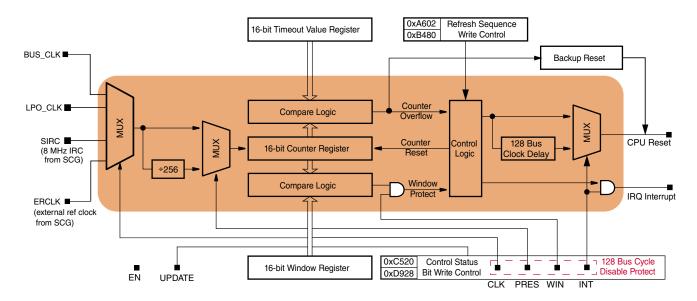


Figure 29-1. WDOG block diagram

29.3 Memory map and register definition

WDOG memory map

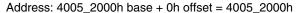
Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page
4005_2000	Watchdog Control and Status Register (WDOG_CS)	32	R/W	See section	29.3.1/608
4005_2004	Watchdog Counter Register (WDOG_CNT)	32	R/W	0000_0000h	29.3.2/611
4005_2008	Watchdog Timeout Value Register (WDOG_TOVAL)	32	R/W	0000_0400h	29.3.3/611
4005_200C	Watchdog Window Register (WDOG_WIN)	32	R/W	0000_0000h	29.3.4/612

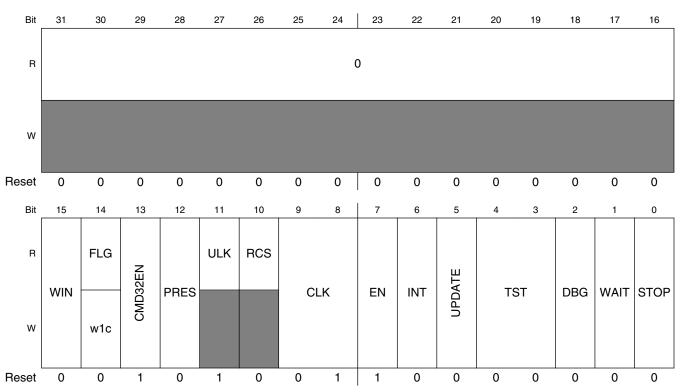
29.3.1 Watchdog Control and Status Register (WDOG_CS)

This section describes the function of Watchdog Control and Status Register.

NOTE

TST is cleared (0:0) on POR only. Any other reset does not affect the value of this field.





WDOG_CS field descriptions

Field	Description
31–16	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.

Table continues on the next page...

WDOG_CS field descriptions (continued)

Field	Description
15	Watchdog Window
WIN	This write-once bit enables window mode. See the Window mode section.
	0 Window mode disabled.
	1 Window mode enabled.
14	Watchdog Interrupt Flag
FLG	This bit is an interrupt indicator when INT is set in control and status register 1. Write 1 to clear it.
	0 No interrupt occurred.
	1 An interrupt occurred.
13 CMD32EN	Enables or disables WDOG support for 32-bit (otherwise 16-bit or 8-bit) refresh/unlock command write words
	This is write-once field, and the user needs to unlock WDOG after writing this field for reconfiguration.
	 Disables support for 32-bit refresh/unlock command write words. Only 16-bit or 8-bit is supported. Enables support for 32-bit refresh/unlock command write words. 16-bit or 8-bit is NOT supported.
12	Watchdog prescaler
PRES	This write-once bit enables a fixed 256 pre-scaling of watchdog counter reference clock. (The block diagram shows this clock divider option.)
	0 256 prescaler disabled.
	1 256 prescaler enabled.
11	Unlock status
ULK	This read-only bit indicates whether WDOG is unlocked or not. Default reset value is 1.
	0 WDOG is locked.
	1 WDOG is unlocked.
10 RCS	Reconfiguration Success
1100	This read-only bit indicates whether the reconfiguration is successful or not. Default reset value is 0. This bit is set when new configuration takes effect, and is cleared by successful unlock command.
	0 Reconfiguring WDOG.
	1 Reconfiguration is successful.
9–8	Watchdog Clock
CLK	This write-once field indicates the clock source that feeds the watchdog counter. See the Clock source section.
	00 Bus clock
	01 LPO clock
	10 System oscillator clock (SOSC, from SCG)
	11 Slow internal reference clock (SIRC, from SCG)
7 EN	Watchdog Enable
EN	This write-once bit enables the watchdog counter to start counting.

Table continues on the next page...

Memory map and register definition

WDOG_CS field descriptions (continued)

Field	Description			
	0 Watchdog disabled.			
	1 Watchdog enabled.			
6 INT	Watchdog Interrupt This write-once bit configures the watchdog to immediately generate an interrupt request upon a reset-triggering event (timeout or illegal write to the watchdog), before forcing a reset. After the interrupt vector			
	fetch (which comes after the reset-triggering event), the reset occurs after a delay of 128 bus clocks.			
	0 Watchdog interrupts are disabled. Watchdog resets are not delayed.			
	1 Watchdog interrupts are enabled. Watchdog resets are delayed by 128 bus clocks from the interrupt vector fetch.			
5 UPDATE	Allow updates			
	This write-once bit allows software to reconfigure the watchdog without a reset.			
	Updates not allowed. After the initial configuration, the watchdog cannot be later modified without forcing a reset.			
	1 Updates allowed. Software can modify the watchdog configuration registers within 128 bus clocks after performing the unlock write sequence.			
4–3	Watchdog Test			
TST	Enables the fast test mode. The test mode allows software to exercise all bits of the counter to demonstrate that the watchdog is functioning properly. See the Fast testing of the watchdog section.			
	This write-once field is cleared (0:0) on POR only. Any other reset does not affect the value of this field.			
	00 Watchdog test mode disabled.			
	Watchdog user mode enabled. (Watchdog test mode disabled.) After testing the watchdog, software should use this setting to indicate that the watchdog is functioning normally in user mode.			
	Watchdog test mode enabled, only the low byte is used. CNT[CNTLOW] is compared with TOVAL[TOVALLOW].			
	11 Watchdog test mode enabled, only the high byte is used. CNT[CNTHIGH] is compared with TOVAL[TOVALHIGH].			
2	Debug Enable			
DBG	This write-once bit enables the watchdog to operate when the chip is in debug mode.			
	0 Watchdog disabled in chip debug mode.			
	1 Watchdog enabled in chip debug mode.			
1 WAIT	Wait Enable			
	This write-once bit enables the watchdog to operate when the chip is in wait mode.			
	0 Watchdog disabled in chip wait mode.			
	1 Watchdog enabled in chip wait mode.			
0 STOP	Stop Enable			
	This write-once bit enables the watchdog to operate when the chip is in stop mode.			
	0 Watchdog disabled in chip stop mode.			
	1 Watchdog enabled in chip stop mode.			

29.3.2 Watchdog Counter Register (WDOG CNT)

This section describes the watchdog counter register.

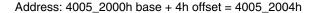
The watchdog counter register provides access to the value of the free-running watchdog counter. Software can read the counter register at any time.

Software cannot write directly to the watchdog counter; however, two write sequences to these registers have special functions:

- 1. The refresh sequence resets the watchdog counter to 0x0000. See the "Refreshing the Watchdog" section.
- 2. The *unlock sequence* allows the watchdog to be reconfigured without forcing a reset (when CS[UPDATE] = 1). See the "Configure for reconfigurable" section.

NOTE

All other writes to this register are illegal and force a reset.





WDOG_CNT field descriptions

Field	Description
31–16 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
15–8 CNTHIGH	High byte of the Watchdog Counter
CNTLOW	Low byte of the Watchdog Counter

29.3.3 Watchdog Timeout Value Register (WDOG TOVAL)

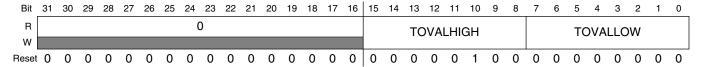
This section describes the watchdog timeout value register. TOVAL contains the 16-bit value used to set the timeout period of the watchdog.

The watchdog counter (CNT) is continuously compared with the timeout value (TOVAL). If the counter reaches the timeout value, the watchdog forces a reset triggering event.

NOTE

Do not write 0 to the Watchdog Timeout Value Register; otherwise, the watchdog always generates a reset.

Address: 4005_2000h base + 8h offset = 4005_2008h



WDOG_TOVAL field descriptions

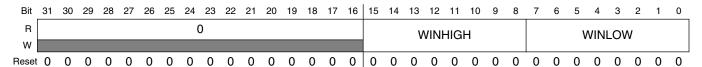
Field	Description
31–16 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
15–8 TOVALHIGH	High byte of the timeout value
TOVALLOW	Low byte of the timeout value

29.3.4 Watchdog Window Register (WDOG_WIN)

This section describes the watchdog window register. When window mode is enabled (CS[WIN] is set), The WIN register determines the earliest time that a refresh sequence is considered valid. See the Watchdog refresh mechanism section.

The WIN register value must be less than the TOVAL register value.

Address: 4005_2000h base + Ch offset = 4005_200Ch



WDOG_WIN field descriptions

Field	Description
31–16 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
15–8 WINHIGH	High byte of Watchdog Window
WINLOW	Low byte of Watchdog Window

613

29.4 Functional description

The WDOG module provides a fail safe mechanism to ensure the system can be reset to a known state of operation in case of system failure, such as the CPU clock stopping or there being a run away condition in the software code. The watchdog counter runs continuously off a selectable clock source and expects to be serviced (refreshed) periodically. If it is not, it generates a reset triggering event.

The timeout period, window mode, and clock source are all programmable but must be configured within 128 bus clocks after a reset.

29.4.1 Clock source

The watchdog counter has the following clock source options selected by programming CS[CLK]:

- bus clock
- internal Low-Power Oscillator clock (LPO_CLK) (This is the default source.)
- internal 8 MHz clock (SIRC)
- external clock (SOSC)

The options allow software to select a clock source independent of the bus clock for applications that need to meet more robust safety requirements. Using a clock source other than the bus clock ensures that the watchdog counter continues to run if the bus clock is somehow halted; see Backup reset.

An optional fixed prescaler for all clock sources allows for longer timeout periods. When CS[PRES] is set, the clock source is prescaled by 256 before clocking the watchdog counter.

The following table summarizes the different watchdog timeout periods available.

Watchdog time-out availability Reference clock **Prescaler** \sim 1 ms-65.5 s (if LPO_CLK = 1 kHz); (\sim 1 ms-65.5 s)/128 (if Pass through $LPO_CLK = 128 \text{ kHz}).$ Internal LPO_CLK ~256 ms-16,777.2 s (if LPO_CLK = 1 kHz); ~2 ms-131.1 s (if ÷256 $LPO_CLK = 128 \text{ kHz}$). Pass through 125 ns-8.1925 ms Internal 8 MHz (SIRC) ÷256 32 µs-2.09728 s 1 MHz (from bus or external) Pass through 1 µs-65.54 ms

Table 29-2. Watchdog timeout availability

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Functional description

Table 29-2. Watchdog timeout availability (continued)

Reference clock	Prescaler	Watchdog time-out availability
	÷256	256 µs-16.777 s
20 MHz (from bus or external)	Pass through	50 ns-3.277 ms
20 Mil 12 (ITOTH bus of external)	÷256	12.8 µs-838.8 ms

1. The default timeout value after reset is approximately 1 s (if LPO_CLK = 1 kHz), or 1/128 s (if LPO_CLK = 128 kHz).

NOTE

When the programmer switches clock sources during reconfiguration, the watchdog hardware holds the counter at zero for 2.5 periods of the previous clock source and 2.5 periods of the new clock source after the configuration time period (128 bus clocks) ends. This delay ensures a smooth transition before restarting the counter with the new configuration.

29.4.2 Watchdog refresh mechanism

The watchdog resets the MCU if the watchdog counter is not refreshed. A robust refresh mechanism makes it very unlikely that the watchdog can be refreshed by runaway code.

To refresh the watchdog counter, software must execute a refresh write sequence before the timeout period expires. In addition, if window mode is used, software must not start the refresh sequence until after the time value set in the WIN register. See the following figure.

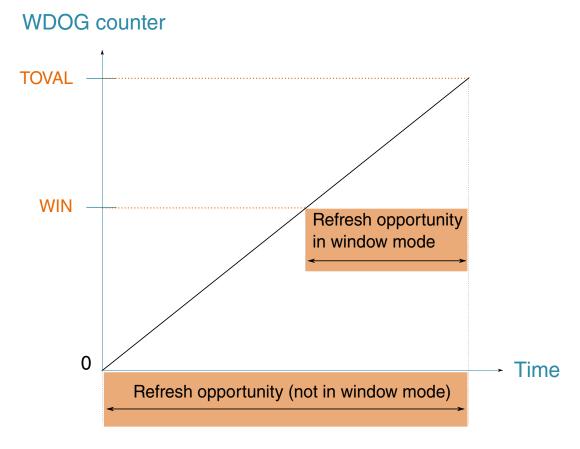


Figure 29-2. Refresh opportunity for the Watchdog counter

29.4.2.1 Window mode

Software finishing its main control loop faster than expected could be an indication of a problem. Depending on the requirements of the application, the WDOG can be programmed to force a reset when refresh attempts are early.

When Window mode is enabled, the watchdog must be refreshed after the counter has reached a minimum expected time value; otherwise, the watchdog resets the MCU. The minimum expected time value is specified in the WIN register. Setting CS[WIN] enables Window mode.

29.4.2.2 Refreshing the Watchdog

The refresh write sequence can be

- either two 16-bit writes (0xA602, 0xB480) or four 8-bit writes (0xA6, 0x02, 0xB4, 0x80) if WDOG_CS[CMD32EN] is 0;
- one 32-bit write (0xB480_A602) if WDOG_CS[CMD32EN] is 1.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Configuring the Watchdog

to the CNT register. Both methods must occur before the WDG timeout; otherwise, the watchdog resets the MCU.

Note

Before starting the refresh sequence, disable the global interrupts. Otherwise, an interrupt could effectively invalidate the refresh sequence, if the interrupt occurs before the refresh writes finish. After the sequence finishes, restore the global interrupt control state.

The example codes can be found in the "Application Information" section of this chapter.

29.4.3 Configuring the Watchdog

29.4.3.1 Configuring the Watchdog Once

All watchdog control bits, timeout value, and window value are write-once after reset within 128 bus clocks. This means that after a write has occurred they cannot be changed unless a reset occurs. This is guaranteed by the user configuring the window and timeout value first, followed by the other control bits, and ensuring that CS[UPDATE] is also set to 0.

This provides a robust mechanism to configure the watchdog and ensure that a runaway condition cannot mistakenly disable or modify the watchdog configuration after configured.

The new configuration takes effect only after all registers except CNT are written after reset. Otherwise, the WDOG uses the reset values by default. If window mode is not used (CS[WIN] is 0), writing to WIN is not required to make the new configuration take effect.

29.4.3.2 Reconfiguring the Watchdog

In some cases (like when supporting a bootloader function), you may want to reconfigure or disable the watchdog, *without forcing a reset first*.

- By setting CS[UPDATE] to 1 on the initial configuration of the watchdog after a reset, you can reconfigure the watchdog at any time by executing an unlock sequence.
- Conversely, if CS[UPDATE] remains 0, the only way to reconfigure the watchdog is by initiating a reset.

617

The unlock sequence is similar to the refresh sequence but uses different values.

29.4.3.2.1 Unlocking the Watchdog

The unlock sequence is a write to the CNT register of 0xC520 followed by 0xD928 within 16 bus clocks at any time after the watchdog has been configured. On completing the unlock sequence, the user must reconfigure the watchdog within 128 bus clocks; otherwise, the watchdog closes the unlock window.

NOTE

Due to the 128 bus clocks requirement for reconfiguring the watchdog, some delays must be inserted before executing STOP or WAIT instructions after reconfiguring the watchdog. This ensures that the watchdog's new configuration takes effect before the MCU enters low power mode. Otherwise, the MCU may not be waken up from low power mode.

The example codes can be found at end of this chapter.

29.4.4 Using interrupts to delay resets

- When interrupts are enabled (CS[INT] = 1): After a reset-triggering event (like a counter timeout or invalid refresh attempt), the watchdog first generates an interrupt request. Next, the watchdog delays 128 bus clocks (from the interrupt vector fetch, not the reset-triggering event) before forcing a reset, to allow the interrupt service routine (ISR) to perform tasks (like analyzing the stack to debug code).
- When interrupts are disabled (CS[INT] = 0): the watchdog does not delay the forcing a reset.

29.4.5 Backup reset

NOTE

A clock source other than the bus clock must be used as the reference clock for the counter; otherwise, the backup reset function is not available.

The backup reset function is a safeguard feature that independently generates a reset in case the main WDOG logic loses its clock (the bus clock) and can no longer monitor the counter. If the watchdog counter overflows twice in succession (without an intervening reset), the backup reset function takes effect and generates a reset.

29.4.6 Functionality in debug and low-power modes

By default, the watchdog is not functional in Debug mode, Wait mode, or Stop mode. However, the watchdog can remain functional in these modes as follows:

- For Debug mode, set CS[DBG]. (This way the watchdog is functional in Debug mode even when the CPU is held by the Debug module.)
- For Wait mode, set CS[WAIT].
- For Stop mode, set CS[STOP], CS[WAIT], and ensure the clock source is active in STOP mode.

NOTE

For Debug mode and Stop mode, in addition to the above configurations, a clock source other than the bus clock must be used as the reference clock for the counter; otherwise, the watchdog cannot function.

29.4.7 Fast testing of the watchdog

Before executing application code in safety critical applications, users are required to test that the watchdog works as expected and resets the MCU. Testing every bit of a 16-bit counter by letting it run to the overflow value takes a relatively long time (64 kHz clocks).

To help minimize the startup delay for application code after reset, the watchdog has a feature to test the watchdog more quickly by splitting the counter into its constituent byte-wide stages. The low and high bytes are run independently and tested for timeout against the corresponding byte of the timeout value register. (For complete coverage when testing the high byte of the counter, the test feature feeds the input clock via the 8th bit of the low byte, thus ensuring that the overflow connection from the low byte to the high byte is tested.)

Using this test feature reduces the test time to 512 clocks (not including overhead, such as user configuration and reset vector fetches). To further speed testing, use a faster clock (such as the bus clock) for the counter reference.

On a power-on reset, the POR bit in the system reset register is set, indicating the user should perform the WDOG fast test.

29.4.7.1 Testing each byte of the counter

The test procedure follows these steps:

- 1. Program the preferred watchdog timeout value in the TOVAL register during the watchdog configuration time period.
- 2. Select a byte of the counter to test using the CS[TST] = 10b for the low byte; CS[TST] = 11b for the high byte.
- 3. Wait for the watchdog to timeout. Optionally, in the idle loop, increment RAM locations as a parallel software counter for later comparison. Because the RAM is not affected by a watchdog reset, the timeout period of the watchdog counter can be compared with the software counter to verify the timeout period has occurred as expected.
- 4. The watchdog counter times out and forces a reset.
- 5. Confirm the WDOG flag in the system reset register is set, indicating that the watchdog caused the reset. (The POR flag remains clear.)
- 6. Confirm that CS[TST] shows a test (10b or 11b) was performed.

If confirmed, the count and compare functions work for the selected byte. Repeat the procedure, selecting the other byte in step 2.

NOTE

CS[TST] is cleared by a POR only and not affected by other resets.

29.4.7.2 Entering user mode

After successfully testing the low and high bytes of the watchdog counter, the user can configure CS[TST] to 01b to indicate the watchdog is ready for use in application user mode. Thus if a reset occurs again, software can recognize the reset trigger as a real watchdog reset caused by runaway or faulty application code.

As an ongoing test when using the default LPO clock source, software can periodically read the CNT register to ensure the counter is being incremented.

29.5 Application Information

The watchdog is enabled by default after reset. To disable or reconfigure the watchdog, it is better to be done before the first watchdog timeout. It is suggested to disable or reconfigure the watchdog at the very beginning of the software code, e.g. beginning of the startup or main function.

NOTE

When the watchdog is configured by user, it needs at least 2.5 periods of watchdog clock to take effect. This means interval between two configures by user must be larger than 2.5 clocks.

NOTE

When Chip startup from BOOT ROM then jump to flash, the watchdog would be enabled in the beginning of bootloader, and disabled when bootloader exits. If there is any code in the flash program want to reconfigure the watchdog, it must be run 2.5 watchdog clocks later after the bootloader exits.

To disable or reconfigure the watchdog without forcing a reset, the unlock sequence must be done.

29.5.1 Disable Watchdog

To disable the watchdog, first do unlock sequence, then unset the WDOG_CS[EN] bit.

```
DisableInterrupts; // disable global interrupt
WDOG_CNT = 0xD928C520; // unlock watchdog
WDOG_CS &= ~WDOG_CS_EN_MASK; // disable watchdog
EnableInterrupts; // enable global interrupt
```

29.5.2 Configure Watchdog

The watchdog can be configured once by set the WDOG_CS[UPDATE]=0. After that, the watchdog cannot be reconfigured until a reset. If set WDOG_CS[UPDATE]=1 when configuring the watchdog, the watchdog can be reconfigured without forcing a reset. The following example code shows how to configure the watchdog without window mode, clock source as LPO, interrupt enabled and timeout value to 256 clocks.

Configure once

Configure for reconfigurable

```
DisableInterrupts; //disable global interrupt
WDOG_CNT = 0xD928C520; //unlock watchdog
while(WDOG_CS[ULK]==0); //wait until registers are unlocked
WDOG_TOVAL = 256; //set timeout value
WDOG_CS = WDOG_CS_EN(1) | WDOG_CS_CLK(1) | WDOG_CS_INT(1) |
```

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

```
WDOG_CS_WIN(0) | WDOG_CS_UPDATE(1);
while(WDOG_CS[RCS]==0); //wait until new configuration takes effect
EnableInterrupts; //enable global interrupt
```

29.5.3 Refreshing the Watchdog

To refresh the watchdog and reset the watchdog counter to zero, a refresh sequence is required:

```
DisableInterrupts; // disable global interrupt
WDOG_CNT = 0xB480A602; // refresh watchdog
EnableInterrupts; // enable global interrupt
```

Application Information

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Chapter 30 Cyclic Redundancy Check (CRC)

30.1 Introduction

The cyclic redundancy check (CRC) module generates 16/32-bit CRC code for error detection.

The CRC module provides a programmable polynomial and other parameters required to implement a 16-bit or 32-bit CRC standard.

The 16/32-bit code is calculated for 32 bits of data at a time.

30.1.1 Features

Features of the CRC module include:

- Hardware CRC generator circuit using a 16-bit or 32-bit programmable shift register
- Programmable initial seed value and polynomial
- Option to transpose input data or output data (the CRC result) bitwise or bytewise. This option is required for certain CRC standards. A bytewise transpose operation is not possible when accessing the CRC data register via 8-bit accesses. In this case, the user's software must perform the bytewise transpose function.
- Option for inversion of final CRC result
- 32-bit CPU register programming interface

30.1.2 Block diagram

The following is a block diagram of the CRC.

Memory map and register descriptions

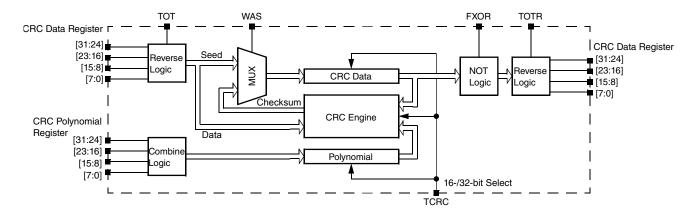


Figure 30-1. Programmable cyclic redundancy check (CRC) block diagram

Modes of operation 30.1.3

Various MCU modes affect the CRC module's functionality.

30.1.3.1 Run mode

This is the basic mode of operation.

Low-power modes (Wait or Stop) 30.1.3.2

Any CRC calculation in progress stops when the MCU enters a low-power mode that disables the module clock. It resumes after the clock is enabled or via the system reset for exiting the low-power mode. Clock gating for this module is dependent on the MCU.

30.2 Memory map and register descriptions

CRC memory map

Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page
4003_2000	CRC Data register (CRC_DATA)	32	R/W	FFFF_FFFFh	30.2.1/625
4003_2004	CRC Polynomial register (CRC_GPOLY)	32	R/W	0000_1021h	30.2.2/626
4003_2008	CRC Control register (CRC_CTRL)	32	R/W	0000_0000h	30.2.3/626

30.2.1 CRC Data register (CRC_DATA)

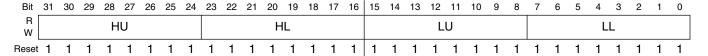
The CRC Data register contains the value of the seed, data, and checksum. When CTRL[WAS] is set, any write to the data register is regarded as the seed value. When CTRL[WAS] is cleared, any write to the data register is regarded as data for general CRC computation.

In 16-bit CRC mode, the HU and HL fields are not used for programming the seed value, and reads of these fields return an indeterminate value. In 32-bit CRC mode, all fields are used for programming the seed value.

When programming data values, the values can be written 8 bits, 16 bits, or 32 bits at a time, provided all bytes are contiguous; with MSB of data value written first.

After all data values are written, the CRC result can be read from this data register. In 16-bit CRC mode, the CRC result is available in the LU and LL fields. In 32-bit CRC mode, all fields contain the result. Reads of this register at any time return the intermediate CRC value, provided the CRC module is configured.

Address: 4003_2000h base + 0h offset = 4003_2000h



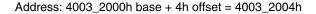
CRC_DATA field descriptions

Field	Description
31–24 HU	CRC High Upper Byte
	In 16-bit CRC mode (CTRL[TCRC] is 0), this field is not used for programming a seed value. In 32-bit CRC mode (CTRL[TCRC] is 1), values written to this field are part of the seed value when CTRL[WAS] is 1. When CTRL[WAS] is 0, data written to this field is used for CRC checksum generation in both 16-bit and 32-bit CRC modes.
23–16	CRC High Lower Byte
HL	In 16-bit CRC mode (CTRL[TCRC] is 0), this field is not used for programming a seed value. In 32-bit CRC mode (CTRL[TCRC] is 1), values written to this field are part of the seed value when CTRL[WAS] is 1. When CTRL[WAS] is 0, data written to this field is used for CRC checksum generation in both 16-bit and 32-bit CRC modes.
15–8	CRC Low Upper Byte
LU	When CTRL[WAS] is 1, values written to this field are part of the seed value. When CTRL[WAS] is 0, data written to this field is used for CRC checksum generation.
LL	CRC Low Lower Byte
	When CTRL[WAS] is 1, values written to this field are part of the seed value. When CTRL[WAS] is 0, data written to this field is used for CRC checksum generation.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

30.2.2 CRC Polynomial register (CRC_GPOLY)

This register contains the value of the polynomial for the CRC calculation. The HIGH field contains the upper 16 bits of the CRC polynomial, which are used only in 32-bit CRC mode. Writes to the HIGH field are ignored in 16-bit CRC mode. The LOW field contains the lower 16 bits of the CRC polynomial, which are used in both 16- and 32-bit CRC modes.



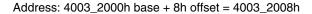
Bit	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
R								HI	211															1.0	W							
W								ПІ	ЗΠ															LC	, v v							
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	1	0	0	0	0	1

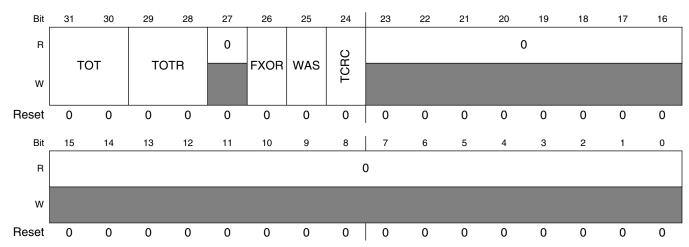
CRC_GPOLY field descriptions

Field	Description
31–16 HIGH	High Polynominal Half-word
	Writable and readable in 32-bit CRC mode (CTRL[TCRC] is 1). This field is not writable in 16-bit CRC mode (CTRL[TCRC] is 0).
LOW	Low Polynominal Half-word
	Writable and readable in both 32-bit and 16-bit CRC modes.

30.2.3 CRC Control register (CRC_CTRL)

This register controls the configuration and working of the CRC module. Appropriate bits must be set before starting a new CRC calculation. A new CRC calculation is initialized by asserting CTRL[WAS] and then writing the seed into the CRC data register.





Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

CRC_CTRL field descriptions

Field	Description
31–30	Type Of Transpose For Writes
ТОТ	Defines the transpose configuration of the data written to the CRC data register. See the description of the transpose feature for the available transpose options.
	00 No transposition.
	01 Bits in bytes are transposed; bytes are not transposed.
	10 Both bits in bytes and bytes are transposed.
	11 Only bytes are transposed; no bits in a byte are transposed.
29–28 TOTR	Type Of Transpose For Read
	Identifies the transpose configuration of the value read from the CRC Data register. See the description of the transpose feature for the available transpose options.
	00 No transposition.
	01 Bits in bytes are transposed; bytes are not transposed.
	10 Both bits in bytes and bytes are transposed.
	11 Only bytes are transposed; no bits in a byte are transposed.
27 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
26 FXOR	Complement Read Of CRC Data Register
	Some CRC protocols require the final checksum to be XORed with 0xFFFFFFF or 0xFFFF. Asserting this bit enables on the fly complementing of read data.
	0 No XOR on reading.
	1 Invert or complement the read value of the CRC Data register.
25 WAS	Write CRC Data Register As Seed
	When asserted, a value written to the CRC data register is considered a seed value. When deasserted, a value written to the CRC data register is taken as data for CRC computation.
	0 Writes to the CRC data register are data values.
	Writes to the CRC data register are seed values.
24 TCRC	Width of CRC protocol.
	0 16-bit CRC protocol.
	1 32-bit CRC protocol.
Reserved	This field is reserved. This read-only field is reserved and always has the value 0.

30.3 Functional description

30.3.1 CRC initialization/reinitialization

To enable the CRC calculation, the user must program CRC_CTRL[WAS], CRC_GPOLY,necessary parameters for transposition and CRC result inversion in the applicable registers. Asserting CRC_CTRL[WAS] enables the programming of the seed value into the CRC_DATA register.

After a completed CRC calculation, the module can be reinitialized for a new CRC computation by reasserting CRC_CTRL[WAS] and programming a new, or previously used, seed value. All other parameters must be set before programming the seed value and subsequent data values.

30.3.2 CRC calculations

In 16-bit and 32-bit CRC modes, data values can be programmed 8 bits, 16 bits, or 32 bits at a time, provided all bytes are contiguous. Noncontiguous bytes can lead to an incorrect CRC computation.

30.3.2.1 16-bit CRC

To compute a 16-bit CRC:

- 1. Clear CRC_CTRL[TCRC] to enable 16-bit CRC mode.
- 2. Program the transpose and complement options in the CTRL register as required for the CRC calculation. See Transpose feature and CRC result complement for details.
- 3. Write a 16-bit polynomial to the CRC_GPOLY[LOW] field. The CRC_GPOLY[HIGH] field is not usable in 16-bit CRC mode.
- 4. Set CRC_CTRL[WAS] to program the seed value.
- 5. Write a 16-bit seed to CRC_DATA[LU:LL]. CRC_DATA[HU:HL] are not used.
- 6. Clear CRC_CTRL[WAS] to start writing data values.
- 7. Write data values into CRC_DATA[HU:HL:LU:LL]. A CRC is computed on every data value write, and the intermediate CRC result is stored back into CRC_DATA[LU:LL].
- 8. When all values have been written, read the final CRC result from CRC_DATA[LU:LL].

Transpose and complement operations are performed on the fly while reading or writing values. See Transpose feature and CRC result complement for details.

629

30.3.2.2 32-bit CRC

To compute a 32-bit CRC:

- 1. Set CRC_CTRL[TCRC] to enable 32-bit CRC mode.
- 2. Program the transpose and complement options in the CTRL register as required for the CRC calculation. See Transpose feature and CRC result complement for details.
- 3. Write a 32-bit polynomial to CRC_GPOLY[HIGH:LOW].
- 4. Set CRC_CTRL[WAS] to program the seed value.
- 5. Write a 32-bit seed to CRC_DATA[HU:HL:LU:LL].
- 6. Clear CRC_CTRL[WAS] to start writing data values.
- 7. Write data values into CRC_DATA[HU:HL:LU:LL]. A CRC is computed on every data value write, and the intermediate CRC result is stored back into CRC_DATA[HU:HL:LU:LL].
- 8. When all values have been written, read the final CRC result from CRC_DATA[HU:HL:LU:LL]. The CRC is calculated bytewise, and two clocks are required to complete one CRC calculation.

Transpose and complement operations are performed on the fly while reading or writing values. See Transpose feature and CRC result complement for details.

30.3.3 Transpose feature

By default, the transpose feature is not enabled. However, some CRC standards require the input data and/or the final checksum to be transposed. The user software has the option to configure each transpose operation separately, as desired by the CRC standard. The data is transposed on the fly while being read or written.

Some protocols use little endian format for the data stream to calculate a CRC. In this case, the transpose feature usefully flips the bits. This transpose option is one of the types supported by the CRC module.

30.3.3.1 Types of transpose

The CRC module provides several types of transpose functions to flip the bits and/or bytes, for both writing input data and reading the CRC result, separately using the CTRL[TOT] or CTRL[TOTR] fields, according to the CRC calculation being used.

The following types of transpose functions are available for writing to and reading from the CRC data register:

1. CTRL[TOT] or CTRL[TOTR] is 00.

Functional description

No transposition occurs.

2. CTRL[TOT] or CTRL[TOTR] is 01

Bits in a byte are transposed, while bytes are not transposed.

reg[31:0] becomes {reg[24:31], reg[16:23], reg[8:15], reg[0:7]}

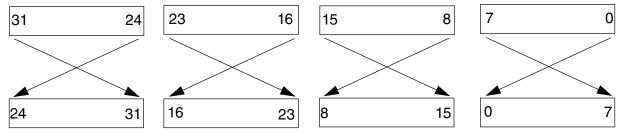


Figure 30-2. Transpose type 01

3. CTRL[TOT] or CTRL[TOTR] is 10.

Both bits in bytes and bytes are transposed.

reg[31:0] becomes = {reg[0:7], reg[8:15], reg[16:23], reg[24:31]}

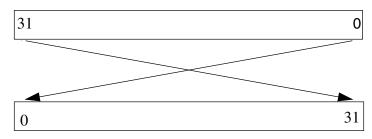


Figure 30-3. Transpose type 10

4. CTRL[TOT] or CTRL[TOTR] is 11.

Bytes are transposed, but bits are not transposed.

reg[31:0] becomes {reg[7:0], reg[15:8], reg[23:16], reg[31:24]}

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018



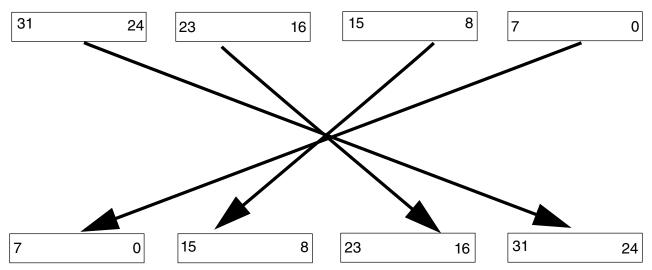


Figure 30-4. Transpose type 11

NOTE

- For 8-bit and 16-bit write accesses to the CRC data register, the data is transposed with zeros on the unused byte or bytes (taking 32 bits as a whole), but the CRC is calculated on the valid byte(s) only.
- When reading the CRC data register for a 16-bit CRC result and using transpose options 10 and 11, the resulting value after transposition resides in the CRC[HU:HL] fields. The user software must account for this situation when reading the 16-bit CRC result, so reading 32 bits is preferred.

30.3.4 CRC result complement

When CTRL[FXOR] is set, the checksum is complemented. The CRC result complement function outputs the complement of the checksum value stored in the CRC data register every time the CRC data register is read. When CTRL[FXOR] is cleared, reading the CRC data register accesses the raw checksum value.

30.4 Usage Guide

When programming data values, the values can be written 8 bits, 16 bits, or 32 bits at a time, provided all bytes are contiguous. The DATA register is written with MSB of data value first, thus the application with little-endian configured, the data write bytes transpose should be enabled when writing a 32bit value from variable to DATA register.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Usage Guide

After all data values are written, the CRC result can be read from this data register. For a 16-bit CRC result, if transpose options 10 and 11 is used, the resulting value after transposition resides in the CRC[HU:HL] fields.

This section shows two examples of using CRC module to implement typical CRC algorithms, including both 32-bit and 16-bit algorithms.

30.4.1 32-bit POSIX CRC

CRC-32/POSIX: width=32 poly=0x04c11db7 init=0x00000000 refin=false refout=false xorout=0xffffffff check=0x765e7680

```
uint32 t checksum32, dataSize;
uint8 \pm data[] = "123456789";
uint32_t *data32;
// Transport Bytes for data write, as the CRC_DATA requires MSB write first
// No transport for checksum read, enable complement read as xorout not zero
// write polynomial register
CRC\_GPOLY = 0x04c11bd7;
// write pre-computed control register value along with WAS to start checksum computation
CRC_CTRL |= CRC_CTRL_WAS(1);
// write seed (initial checksum)
CRC_DATA = 0;
// deassert WAS by writing pre-computed CRC control register value
CRC CTRL &= ~CRC CTRL WAS(1);
// write data
dataSize = sizeof(data);
// 8-bit reads and writes till source address is aligned 4 bytes */
while ((data) && ((uint32_t)data & 3U))
   CRC DATA = *data;
   data++:
   dataSize--;
// use 32-bit reads and writes as long as possible
data32 = (uint32_t *)data;
while (dataSize >= sizeof(uint32_t))
   CRC DATA = *data32;
   data32++;
   dataSize -= sizeof(uint32 t);
data = (uint8 t *)data32;
// 8-bit reads and writes till end of data buffer
while (dataSize)
   CRC DATA = *data;
   data++:
   dataSize--;
// read 32bit checksum result
checksum32 = CRC DATA;
```

30.4.2 16-bit KERMIT CRC

CRC-16/KERMIT: width=16 poly=0x1021 init=0x0000 refin=true refout=true xorout=0x0000 check=0x2189

```
uint32_t checksum16, dataSize;
uint8 t data[] = "123456789";
uint32_t *data32;
// Transport Bytes and Bits for both data write and read
// Bytes transport is because of the CRC_DATA requires MSB write first
// Bits transport is because of the KERMIT algorithm requirement
// No complement for checksum result
CRC_CTRL = CRC_CTRL_TOT(2) | CRC_CTRL_TOTR(2) | CRC_CTRL_FXOR(0) | CRC_CTRL_TCRC(0) | CRC_CTRL_WAS(0);
// write polynomial register
CRC GPOLY = 0x1021;
// write pre-computed control register value along with WAS to start checksum computation
CRC_CTRL |= CRC_CTRL_WAS(1);
// write seed (initial checksum)
CRC DATA = 0;
// deassert WAS by writing pre-computed CRC control register value
CRC CTRL &= ~CRC CTRL WAS(1);
// write data
dataSize = sizeof(data);
// 8-bit reads and writes till source address is aligned 4 bytes ^{\star}/
while ((data) && ((uint32_t)data & 3U))
    CRC_DATA = *data;
    data++;
    dataSize--;
// use 32-bit reads and writes as long as possible
data32 = (uint32 t *) data;
while (dataSize >= sizeof(uint32_t))
    CRC DATA = *data32;
    data32++;
    dataSize -= sizeof(uint32_t);
data = (uint8_t *)data32;
// 8-bit reads and writes till end of data buffer
while (dataSize)
    CRC DATA = *data;
    data++:
    dataSize--;
// due to the transport option TOTR >= 2
// read 16bit checksum result from CRC_DATA[HU:HL]
// otherwise, read checksum from CRC_DATA[LU:LL]
checksum16 = (CRC DATA & 0xFFFF0000) >> 16;
```

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Usage Guide

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Chapter 31 Debug

31.1 Introduction

This device's debug is based on the ARM CoreSight architecture and is configured to provide the maximum flexibility as allowed by the restrictions of the pinout and other available resources.

It provides register and memory accessibility from the external debugger interface, basic run/halt control plus 2 breakpoints and 2 watchpoints. Additionally, it supports ARM's Basic BranchBuffer (BBB) capability to provide simple program trace.

This device supports only one debug interface, Serial Wire Debug (SWD).

31.2 Debug port pin descriptions

The debug port pins default to their SWD functionality after power-on-reset (POR).

 Pin Name
 Type
 Description

 SWD_CLK
 Input
 Serial Wire Clock. This pin is the clock for debug logic when in the Serial Wire Debug mode.

 SWD_DIO
 Input / Output
 Serial Wire Debug Data input/output. The SWD_DIO pin is used by an external debug tool for communication and device control. This pin is pulled up internally.

Table 31-1. Serial wire debug pin description

31.3 SWD status and control registers

Through the ARM Debug Access Port (DAP), the debugger has access to the status and control elements, implemented as registers on the DAP bus as shown in Figure 31-1. These registers provide additional control and status for low-power mode recovery and

SWD status and control registers

typical run-control scenarios. The status register bits also provide a means for the debugger to get updated status of the core without having to initiate a bus transaction across the crossbar switch, thus remaining less intrusive during a debug session.

A miscellaneous debug module (MDM) is implemented on this device, which contains the DAP control and status registers. It is important to note that these DAP control and status registers are not memory-mapped within the system memory map and are only accessible via the Debug Access Port using SWD. The MDM-AP is accessible as Debug Access Port 1 with the available registers shown in the table below.

Table 31-2. MDM-AP register summary

Address	Register	Description
0x0100_0000	Status	See MDM-AP status register
0x0100_0004	Control	See MDM-AP Control register
0x0100_00FC		Read-only identification register that always reads as 0x001C_0020

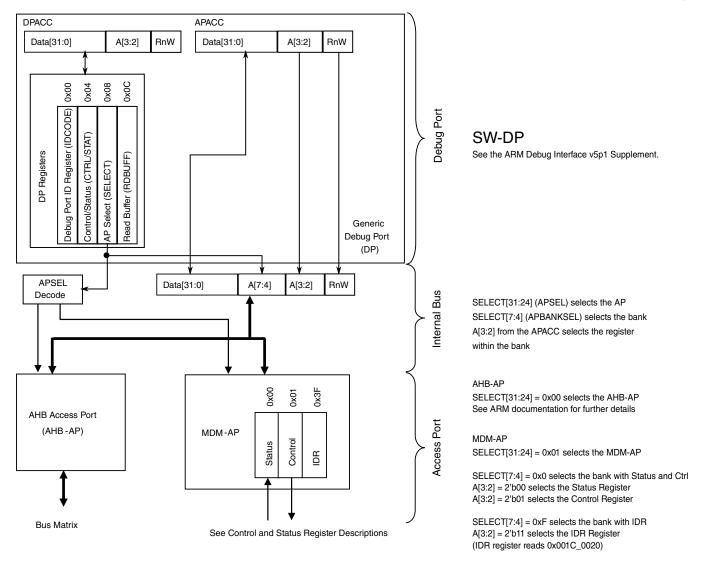


Figure 31-1. MDM AP addressing

31.3.1 MDM-AP status register

Table 31-3. MDM-AP status register assignments

L	Bit	Name	Description
	0	Flash Mass Erase Acknowledge	The Flash Mass Erase Acknowledge field is cleared after POR reset. The field is also cleared at launch of a mass erase command due to write of Flash Mass Erase in Progress field in MDM AP Control Register. The Flash Mass Erase Acknowledge is set after Flash control logic has started the mass erase operation.
	1	Flash Ready	Indicates that flash memory has been initialized and debugger can be configured even if system is continuing to be held in reset via the debugger. 0 Flash is under initialization.

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

SWD status and control registers

Table 31-3. MDM-AP status register assignments (continued)

Bit	Name	Description
		1 Flash is ready.
2	System Security	Indicates the security state. When secure, the debugger does not have access to the system bus or any memory mapped peripherals. This field indicates when the part is locked and no system bus access is possible.
		NOTE: This bit is not valid until Flash Ready bit set.
		0 Device is unsecured.
		1 Device is secured.
3	System Reset	Indicates the system reset state.
		0 System is in reset.
		1 System is not in reset.
4	Reserved	
5 – 15	Reserved for future use	Always read 0.
16	Core Halted	Indicates the core has entered Debug Halt mode
		0 Core is not halted.
		1 Core is halted.
17	Core SLEEPDEEP	SLEEPDEEP=1 indicates the core has entered Stop mode.
18	Core SLEEPING	SLEEPING=1 indicates the core has entered Wait mode.
19 – 31	Reserved for future use	Always reads 0.

31.3.2 MDM-AP Control register

Table 31-4. MDM-AP Control register assignments

Bit	Name	Secure ¹	Description
0	Flash Mass Erase in Progress	Y	Set to cause mass erase. Cleared by hardware after mass erase operation completes.
1	Debug Disable	N	Set to disable debug. Clear to allow debug operation. When set, it overrides the C_DEBUGEN field within the DHCSR ² and forces to disable Debug logic.
2	Debug Request	N	Set to force the core to halt.
			If the core is in Stop or Wait mode, this field can be used to wake the core and transition to a halted state.
3	System Reset Request	Υ	Set to force a system reset. The system remains held in reset until this field is cleared. When this bit is set, RESET pin does not reflect the status of system reset and does not keep low.
4	Core Hold	N	Configuration field to control core operation at the end of system reset sequencing.
			0 Normal operation—release the core from reset along with the rest of the system at the end of system reset sequencing.

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

639

Table 31-4. MDM-AP Control register assignments (continued)

Bit	Name	Secure ¹	Description
			1 Suspend operation—hold the core in reset at the end of reset sequencing. Once the system enters this suspended state, clearing this control bit immediately releases the core from reset and CPU operation begins.
5-31	Reserved for future use	N	

- 1. Command available in secure mode
- 2. DHCSR: refer to the Debug Halting Control and Status Register in the ARMv6-M Architecture Reference Mannual.

31.4 Debug resets

The debug system receives the following sources of reset:

System POR reset

Conversely, the debug system is capable of generating system reset using the following mechanism:

- A system reset in the DAP control register which allows the debugger to hold the system in reset.
- Writing 1 to the SYSRESETREQ field in the NVIC Application Interrupt and Reset Control register
- A system reset in the DAP control register which allows the debugger to hold the core in reset.

31.5 Micro Trace Buffer (MTB)

The Micro Trace Buffer (MTB) provides a simple execution trace capability for the Cortex-M0+ processor. When enabled, the MTB records changes in program flow reported by the Cortex-M0+ processor, via the execution trace interface, into a configurable region of the SRAM. Subsequently an off-chip debugger may extract the trace information, which would allow reconstruction of an instruction flow trace. The MTB does not include any form of load/store data trace capability or tracing of any other information.

In addition to providing the trace capability, the MTB also operates as a simple AHB-Lite SRAM controller. The system bus masters, including the processor, have read/write access to all of the SRAM via the AHB-Lite interface, allowing the memory to also be used to store program and data information. The MTB simultaneously stores the trace

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Debug in low-power modes

information into an attached SRAM and allows bus masters to access the memory. The MTB ensures that trace information write accesses to the SRAM take priority over accesses from the AHB-Lite interface.

The MTB includes trace control registers for configuring and triggering the MTB functions. The MTB also supports triggering via TSTART and TSTOP control functions in the MTB DWT module.

31.6 Debug in low-power modes

In low-power modes in which the debug modules are kept static or powered off, the debugger cannot gather any debug data for the duration of the low-power mode.

- If the debugger is held static, the debug port returns to full functionality as soon as the low-power mode exits and the system returns to a state with active debug.
- If the debugger logic is powered off, the debugger is reset on recovery and must be reconfigured once the low-power mode is exited.

The active debug will prevent the chip from entering low-power mode. In case the chip is already in low-power mode, a debug request from MDM-AP control register will wake the chip from low-power mode.

31.7 **Debug and security**

When flash security is enabled, the debug port capabilities are limited in order to prevent exploitation of secure data. In the secure state, the debugger still has access to the status register and can determine the current security state of the device. In the case of a secure device, the debugger has the capability of performing only a mass erase operation.

Chapter 32 Micro Trace Buffer (MTB)

32.1 Introduction

Microcontrollers using the Cortex-M0+ processor core include support for a CoreSight Micro Trace Buffer to provide program trace capabilities.

The proper name for this function is the CoreSight Micro Trace Buffer for the Cortex-M0+ Processor; in this document, it is simply abbreviated as the MTB.

The simple program trace function creates instruction address change-of-flow data packets in a user-defined region of the system RAM. Accordingly, the system RAM controller manages requests from two sources:

- AMBA-AHB reads and writes from the system bus
- program trace packet writes from the processor

As part of the MTB functionality, there is a DWT (Data Watchpoint and Trace) module that allows the user to define watchpoint addresses, or optionally, an address and data value, that when triggered, can be used to start or stop the program trace recording.

This document details the functionality of both the MTB_RAM and MTB_DWT capabilities.

32.1.1 Overview

A generic block diagram of the processor core and platform for this class of ultra low-end microcontrollers is shown as follows:

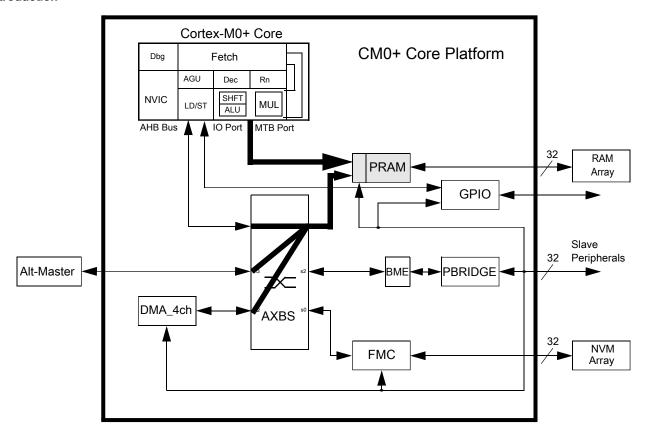


Figure 32-1. Generic Cortex-M0+ core platform block diagram

As shown in the block diagram, the platform RAM (PRAM) controller connects to two input buses:

- the crossbar slave port for system bus accesses
- a "private execution MTB port" from the core

The logical paths from the crossbar master input ports to the PRAM controller are highlighted along with the private execution trace port from the processor core. The private MTB port signals the instruction address information needed for the 64-bit program trace packets written into the system RAM. The PRAM controller output interfaces to the attached RAM array. In this document, the PRAM controller is the MTB_RAM controller.

The following information is taken from the Arm CoreSight Micro Trace Buffer documentation.

"The execution trace packet consists of a pair of 32-bit words that the MTB generates when it detects the processor PC value changes non-sequentially. A non-sequential PC change can occur during branch instructions or during exception entry.

The processor can cause a trace packet to be generated for any instruction.

The following figure shows how the execution trace information is stored in memory as a sequence of packets.

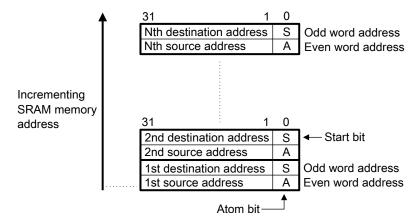


Figure 32-2. MTB execution trace storage format

The first, lower addressed, word contains the source of the branch, the address it branched from. The value stored only records bits[31:1] of the source address, because Thumb instructions are at least halfword aligned. The least significant bit of the value is the A-bit. The A-bit indicates the atomic state of the processor at the time of the branch, and can differentiate whether the branch originated from an instruction in a program, an exception, or a PC update in Debug state. When it is zero the branch originated from an instruction, when it is one the branch originated from an exception or PC update in Debug state. This word is always stored at an even word location.

The second, higher addressed word contains the destination of the branch, the address it branched to. The value stored only records bits[31:1] of the branch address. The least significant bit of the value is the S-bit. The S-bit indicates where the trace started. An Sbit value of 1 indicates where the first packet after the trace started and a value of 0 is used for other packets. Because it is possible to start and stop tracing multiple times in a trace session, the memory might contain several packets with the S-bit set to 1. This word is always stored in the next higher word in memory, an odd word address.

When the A-bit is set to 1, the source address field contains the architecturally-preferred return address for the exception. For example, if an exception was caused by an SVC instruction, then the source address field contains the address of the following instruction. This is different from the case where the A-bit is set to 0. In this case, the source address contains the address of the branch instruction.

For an exception return operation, two packets are generated:

- The first packet has the:
 - Source address field set to the address of the instruction that causes the exception return, BX or POP.

Introduction

- Destination address field set to bits[31:1] of the EXC_RETURN value. See the Arm v6-M Architecture Reference Manual.
- The A-bit set to 0.
- The second packet has the:
 - Source address field set to bits[31:1] of the EXC_RETURN value.
 - Destination address field set to the address of the instruction where execution commences.
 - A-bit set to 1."

Given the recorded change-of-flow trace packets in system RAM and the memory image of the application, a debugger can read out the data and create an instruction-by-instruction program trace. In keeping with the low area and power implementation cost design targets, the MTB trace format is less efficient than other CoreSight trace modules, for example, the ETM (Embedded Trace Macrocell). Since each branch packet is 8 bytes in size, a 1 KB block of system RAM can contain 128 branches. Using the Dhrystone 2.1 benchmark's dynamic runtime as an example, this corresponds to about 875 instructions per KB of trace RAM, or with a zero wait state memory, this corresponds to approximately 1600 processor cycles per KB. This metric is obviously very sensitive to the runtime characteristics of the user code.

The MTB_DWT function (not shown in the core platform block diagram) monitors the processor address and data buses so that configurable watchpoints can be detected to trigger the appropriate response in the MTB recording.

32.1.2 Features

The key features of the MTB_RAM and MTB_DWT include:

- Memory controller for system RAM and Micro Trace Buffer for program trace packets
- Read/write capabilities for system RAM accesses, write-only for program trace packets
- Supports zero wait state response to system bus accesses when no trace data is being written
- Can buffer two AHB address phases and one data write for system RAM accesses
- Supports 64-bit program trace packets including source and destination instruction addresses
- Program trace information in RAM available to MCU's application code or external debugger
- Program trace watchpoint configuration accessible by MCU's application code or debugger
- Location and size of RAM trace buffer is configured by software

645

- Two DWT comparators (addresses or address + data) provide programmable start/ stop recording
- CoreSight compliant debug functionality

32.1.3 Modes of operation

The MTB_RAM and MTB_DWT functions do not support any special modes of operation. The MTB_RAM controller, as a memory-mapped device located on the platform's slave AHB system bus, responds strictly on the basis of memory addresses for accesses to its attached RAM array. The MTB private execution bus provides program trace packet write information to the RAM controller. Both the MTB_RAM and MTB_DWT modules are memory-mapped, so their programming models can be accessed.

All functionality associated with the MTB_RAM and MTB_DWT modules resides in the core platform's clock domain; this includes its connections with the RAM array.

32.2 External signal description

The MTB_RAM and MTB_DWT modules do not directly support any external interfaces.

The internal interface includes a standard AHB bus with a 32-bit datapath width from the appropriate crossbar slave port plus the private execution trace bus from the processor core. The signals in the private execution trace bus are detailed in the following table taken from the Arm CoreSight Micro Trace Buffer documentation. The signal direction is defined as viewed by the MTB_RAM controller.

Table 32-1. Private execution trace port from the core to MTB_RAM

Signal	Direction	Description			
LOCKUP	Input	Indicates the processor is in the Lockup state. This signal is driven LOW for cycles when the processor is executing normally and driven HIGH for every cycle the processor is waiting in the Lockup state. This signal is valid on every cycle.			
IAESEQ	Input	Indicates the next instruction address in execute, IAEX, is sequential, that is non-branching.			
IAEXEN	Input	IAEX register enable.			
IAEX[30:0]	Input	Registered address of the instruction in the execution stage, shifted right by one bit, that is, PC >> 1.			
ATOMIC	Input	Indicates the processor is performing non-instruction related activities.			
EDBGRQ	Output	Request for the processor to enter the Debug state, if enabled, and halt.			

Memory map and register definition

In addition, there are two signals formed by the MTB_DWT module and driven to the MTB_RAM controller: TSTART (trace start) and TSTOP (trace stop). These signals can be configured using the trace watchpoints to define programmable addresses and data values to affect the program trace recording state.

32.3 Memory map and register definition

The MTB_RAM and MTB_DWT modules each support a sparsely-populated 4 KB address space for their programming models. For each address space, there are a variety of control and configurable registers near the base address, followed by a large unused address space and finally a set of CoreSight registers to support dynamic determination of the debug configuration for the device.

Accesses to the programming model follow standard Arm conventions. Taken from the Arm CoreSight Micro Trace Buffer documentation, these are:

- Do not attempt to access reserved or unused address locations. Attempting to access these locations can result in UNPREDICTABLE behavior.
- The behavior of the MTB is UNPREDICTABLE if the registers with UNKNOWN reset values are not programmed prior to enabling trace.
- Unless otherwise stated in the accompanying text:
 - Do not modify reserved register bits
 - Ignore reserved register bits on reads
 - All register bits are reset to a logic 0 by a system or power-on reset
 - Use only word size, 32-bit, transactions to access all registers

32.3.1 MTB_RAM Memory Map

MTB memory map

Absolute address (hex)	Register name		Access	Reset value	Section/ page
F000_0000	MTB Position Register (MTB_POSITION)		R/W	Undefined	32.3.1.1/ 648
F000_0004	MTB Master Register (MTB_MASTER)		R/W	See section	32.3.1.2/ 649
F000_0008	MTB Flow Register (MTB_FLOW)		R/W	Undefined	32.3.1.3/ 651
F000_000C	MTB Base Register (MTB_BASE)		R	Undefined	32.3.1.4/ 653
F000_0F00	Integration Mode Control Register (MTB_MODECTRL)		R	0000_0000h	32.3.1.5/ 653

Table continues on the next page...

MTB memory map (continued)

Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page
F000_0FA0	Claim TAG Set Register (MTB_TAGSET)	32	R	0000_0000h	32.3.1.6/ 654
F000_0FA4	Claim TAG Clear Register (MTB_TAGCLEAR)	32	R	0000_0000h	32.3.1.7/ 654
F000_0FB0	Lock Access Register (MTB_LOCKACCESS)	32	R	0000_0000h	32.3.1.8/ 655
F000_0FB4	Lock Status Register (MTB_LOCKSTAT)	32	R	0000_0000h	32.3.1.9/ 655
F000_0FB8	Authentication Status Register (MTB_AUTHSTAT)	32	R	0000_0000h	32.3.1.10/ 655
F000_0FBC	Device Architecture Register (MTB_DEVICEARCH)	32	R	4770_0A31h	32.3.1.11/ 656
F000_0FC8	Device Configuration Register (MTB_DEVICECFG)	32	R	0000_0000h	32.3.1.12/ 657
F000_0FCC	Device Type Identifier Register (MTB_DEVICETYPID)	32	R	0000_0031h	32.3.1.13/ 657
F000_0FD0	Peripheral ID Register (MTB_PERIPHID4)	32	R	See section	32.3.1.14/ 658
F000_0FD4	Peripheral ID Register (MTB_PERIPHID5)	32	R	See section	32.3.1.14/ 658
F000_0FD8	Peripheral ID Register (MTB_PERIPHID6)	32	R	See section	32.3.1.14/ 658
F000_0FDC	Peripheral ID Register (MTB_PERIPHID7)	32	R	See section	32.3.1.14/ 658
F000_0FE0	Peripheral ID Register (MTB_PERIPHID0)	32	R	See section	32.3.1.14/ 658
F000_0FE4	Peripheral ID Register (MTB_PERIPHID1)	32	R	See section	32.3.1.14/ 658
F000_0FE8	Peripheral ID Register (MTB_PERIPHID2)	32	R	See section	32.3.1.14/ 658
F000_0FEC	Peripheral ID Register (MTB_PERIPHID3)	32	R	See section	32.3.1.14/ 658
F000_0FF0	Component ID Register (MTB_COMPID0)	32	R	See section	32.3.1.15/ 658
F000_0FF4	Component ID Register (MTB_COMPID1)	32	R	See section	32.3.1.15/ 658
F000_0FF8	Component ID Register (MTB_COMPID2)	32	R	See section	32.3.1.15/ 658
F000_0FFC	Component ID Register (MTB_COMPID3)	32	R	See section	32.3.1.15/ 658

32.3.1.1 MTB Position Register (MTB_POSITION)

The MTB_POSITION register contains the Trace Write Address Pointer and Wrap fields. This register can be modified by the explicit programming model writes. It is also automatically updated by the MTB hardware when trace packets are being recorded.

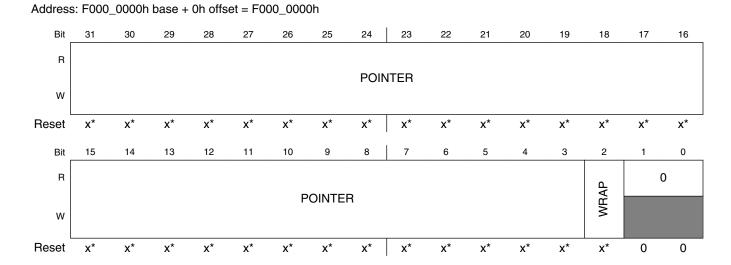
The base address of the system RAM in the memory map dictates special consideration for the placement of the MTB. Consider the following guidelines:

For the standard configuration where the size of the MTB is $\leq 25\%$ of the total RAM capacity, it is recommended the MTB be based at the address defined by the MTB_BASE register. The read-only MTB_BASE register is defined by the expression (0x2000_0000 - (RAM_Size/4)). For this configuration, the MTB_POSITION register is initialized to MTB_BASE & 0x0000_7FF8.

If the size of the MTB is more than 25% but less than or equal to 50% of the total RAM capacity, it is recommended the MTB be based at address $0x2000_0000$. In this configuration, the MTB_POSITION register is initialized to $(0x2000_0000$ & $0x0000_7FF8) = 0x0000_00000$.

Following these two suggested placements provides a full-featured circular memory buffer containing program trace packets.

In the unlikely event an even larger trace buffer is required, a write-once capacity of 75% of the total RAM capacity can be based at address 0x2000_0000. The MTB_POSITION register is initialized to (0x2000_0000 & 0x0000_7FF8) = 0x0000_0000. However, this configuration cannot support operation as a circular queue and instead requires the use of the MTB_FLOW[WATERMARK] capability to automatically disable tracing or halting the processor as the number of packet writes approach the buffer capacity. See the MTB_FLOW register description for more details.



Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

649

- * Notes:
- x = Undefined at reset.

MTB_POSITION field descriptions

Field	Description
31–3	Trace Packet Address Pointer[28:0]
POINTER	Because a packet consists of two words, the POINTER field is the address of the first word of a packet. This field contains bits[31:3] of the RAM address where the next trace packet is written. Therefore, it points to an unused location and is automatically incremented.
	A debug agent can calculate the system memory map address for the current location in the MTB using the following "generic" equation:
	Given mtb_size = 1 << (MTB_MASTER[MASK] + 4),
	systemAddress = MTB_BASE + (((MTB_POSITION & 0xFFFF_FFF8) + (mtb_size - (MTB_BASE & (mtb_size-1)))) & 0x0000_7FF8);
	For this device, a simpler expression also applies. See the following pseudo-code:
	if ((MTB_POSITION >> 13) == 0x3) systemAddress = $(0x1FFF << 16) + (0x1 << 15) + (MTB_POSITION & 0x7FF8)$; else systemAddress = $(0x2000 << 16) + (0x0 << 15) + (MTB_POSITION & 0x7FF8)$;
	NOTE: The size of the RAM is parameterized and the most significant bits of the POINTER field are RAZ/WI.
	For these devices, POSITION[31:15] == POSITION[POINTER[28:12]] are RAZ/WI. Therefore, the active bits in this field are POSITION[14:3] == POSITION[POINTER[11:0]].
2	WRAP
WRAP	This field is set to 1 automatically when the POINTER value wraps as determined by the MTB_MASTER[MASK] field in the MASTER Trace Control Register. A debug agent might use the WRAP field to determine whether the trace information above and below the pointer address is valid.
Reserved	This field is reserved. This read-only field is reserved and always has the value 0.

32.3.1.2 MTB Master Register (MTB_MASTER)

The MTB_MASTER register contains the main program trace enable plus other trace controls. This register can be modified by the explicit programming model writes. MTB_MASTER[EN] and MTB_MASTER[HALTREQ] fields are also automatically updated by the MTB hardware.

Before MTB_MASTER[EN] or MTB_MASTER[TSTARTEN] are set to 1, the software must initialize the MTB_POSITION and MTB_FLOW registers.

If MTB_FLOW[WATERMARK] is used to stop tracing or to halt the processor, MTB_MASTER[MASK] must still be set to a value that prevents MTB_POSITION[POINTER] from wrapping before it reaches the MTB_FLOW[WATERMARK] value.

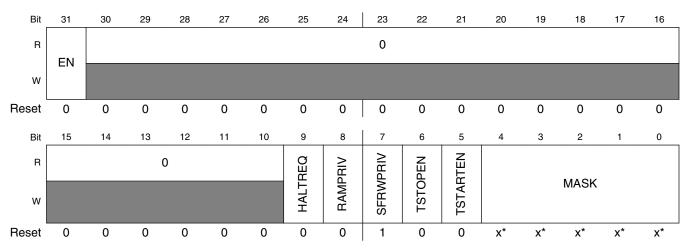
Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Memory map and register definition

NOTE

The format of this mask field is different than MTBDWT_MASKn[MASK].

Address: F000_0000h base + 4h offset = F000_0004h



* Notes:

650

• x = Undefined at reset.

MTB_MASTER field descriptions

Field	Description
31 EN	Main Trace Enable
EIN	When this field is 1, trace data is written into the RAM memory location addressed by MTB_POSITION[POINTER]. The MTB_POSITION[POINTER] value auto increments after the trace data packet is written.
	EN can be automatically set to 0 using the MTB_FLOW[WATERMARK] field and the MTB_FLOW[AUTOSTOP] bit.
	EN is automatically set to 1 if TSTARTEN is 1 and the TSTART signal is HIGH.
	EN is automatically set to 0 if TSTOPEN is 1 and the TSTOP signal is HIGH.
	NOTE: If EN is set to 0 because MTB_FLOW[WATERMARK] is set, then it is not automatically set to 1 if TSTARTEN is 1 and the TSTART input is HIGH. In this case, tracing can only be restarted if MTB_FLOW[WATERMARK] or MTB_POSITION[POINTER] value is changed by software.
30–10 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
9 HALTREQ	Halt Request This field is connected to the halt request signal of the trace logic, EDBGRQ. When HALTREQ is set to 1, the EDBFGRQ is asserted if DBGEN (invasive debug enable, one of the debug authentication interface signals) is also HIGH. HALTREQ can be automatically set to 1 using MTB_FLOW[WATERMARK].
8 RAMPRIV	RAM Privilege
TO WILLIAM	If this field is 0, then user or privileged AHB read and write accesses to the RAM are permitted. If this field is 1, then only privileged AHB read and write accesses to the RAM are permitted and user accesses are RAZ/WI. The HPROT[1] signal determines if an access is a user or privileged mode reference.

Table continues on the next page...

MTB_MASTER field descriptions (continued)

Field	Description
7 SFRWPRIV	Special Function Register Write Privilege
	If this field is 0, then user or privileged AHB read and write accesses to the MTB_RAM Special Function Registers (programming model) are permitted. If this field is 1, then only privileged write accesses are permitted; user write accesses are ignored. The HPROT[1] signal determines if an access is user or privileged. Note MTB_RAM SFR read access are not controlled by this bit and are always permitted.
6 TCTODEN	Trace Stop Input Enable
TSTOPEN	If this field is 1 and the TSTOP signal is HIGH, then EN is set to 0. If a trace packet is being written to memory, the write is completed before tracing is stopped.
5 TSTARTEN	Trace Start Input Enable
ISTARTEN	If this field is 1 and the TSTART signal is HIGH, then EN is set to 1. Tracing continues until a stop condition occurs.
MASK	Mask
	This value determines the maximum size of the trace buffer in RAM. It specifies the most-significant bit of the MTB_POSITION[POINTER] field that can be updated by automatic increment. If the trace tries to advance past this power of 2, the MTB_POSITION[WRAP] bit is set to 1, the MTB_POSITION[MASK+3:3] == MTB_POSITION[POINTER[MASK:0]] bits are set to 0, and the MTB_POSITION[14:MASK+3] == MTB_POSITION[POINTER[11:MASK+1]] bits remain unchanged.
	This field causes the trace packet information to be stored in a circular buffer of size 2^[MASK+4] bytes, that can be positioned in memory at multiples of this size. As detailed in the MTB_POSITION description, typical "upper limits" for the MTB size are RAM_Size/4 or RAM_Size/2. Values greater than the maximum have the same effect as the maximum.

32.3.1.3 MTB Flow Register (MTB_FLOW)

The MTB_FLOW register contains the watermark address and the autostop/autohalt control bits.

If tracing is stopped using the watermark autostop feature, it cannot be restarted until software clears the watermark autostop. This can be achieved in one of the following ways:

- Changing the MTB_POSITION[POINTER] field value to point to the beginning of the trace buffer, or
- Setting MTB_FLOW[AUTOSTOP] = 0.

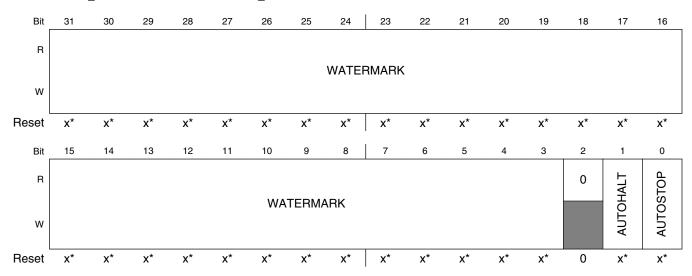
A debug agent can use MTB_FLOW[AUTOSTOP] to fill the trace buffer once only without halting the processor.

A debug agent can use MTB_FLOW[AUTOHALT] to fill the trace buffer once before causing the Cortex-M0+ processor to enter the Debug state. To enter Debug state, the Cortex-M0+ processor might have to perform additional branch type operations. Therefore, the MTB_FLOW[WATERMARK] field must be set below the final entry in the trace buffer region.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Memory map and register definition

Address: F000_0000h base + 8h offset = F000_0008h



^{*} Notes:

MTB_FLOW field descriptions

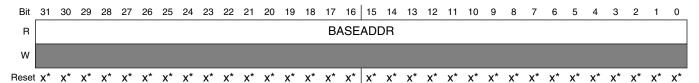
Field	Description
31–3 WATERMARK	WATERMARK[28:0]
	This field contains an address in the same format as the MTB_POSITION[POINTER] field. When MTB_POSITION[POINTER] matches the WATERMARK field value, actions defined by the AUTOHALT and AUTOSTOP bits are performed.
2	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
1	AUTOHALT
AUTOHALT	
	If this field is 1 and WATERMARK is equal to MTB_POSITION[POINTER], then MTB_MASTER[HALTREQ] is automatically set to 1. If the DBGEN signal is HIGH, the MTB asserts this halt request to the Cortex-M0+ processor by asserting the EDBGRQ signal.
0 AUTOSTOP	AUTOSTOP
	If this field is 1 and WATERMARK is equal to MTB_POSITION[POINTER], then MTB_MASTER[EN] is automatically set to 0. This stops tracing.

[•] x = Undefined at reset.

32.3.1.4 MTB Base Register (MTB_BASE)

The read-only MTB_BASE Register indicates where the RAM is located in the system memory map. This register is provided to enable auto discovery of the MTB RAM location, by a debug agent and is defined by a hardware design parameter. For this device, the base address is defined by the expression: MTB_BASE[BASEADDR] = 0x2000_0000 - (RAM_Size/4)

Address: F000_0000h base + Ch offset = F000_000Ch



^{*} Notes:

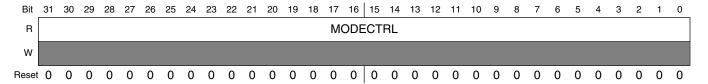
MTB_BASE field descriptions

Field	Description
BASEADDR	BASEADDR
	This value is defined with a hardwired signal and the expression: 0x2000_0000 - (RAM_Size/4). For example, if the total RAM capacity is 16 KB, this field is 0x1FFF_F000.

32.3.1.5 Integration Mode Control Register (MTB_MODECTRL)

This register enables the device to switch from a functional mode, or default behavior, into integration mode. It is hardwired to specific values used during the auto-discovery process by an external debug agent.

Address: F000_0000h base + F00h offset = F000_0F00h



MTB MODECTRL field descriptions

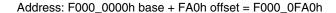
Field	Description
MODECTRL	MODECTRL
	Hardwired to 0x0000_0000

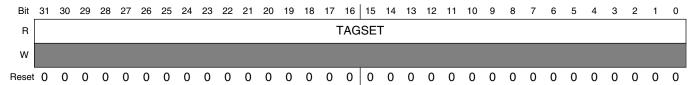
Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

[•] x = Undefined at reset.

32.3.1.6 Claim TAG Set Register (MTB_TAGSET)

The Claim Tag Set Register returns the number of bits that can be set on a read, and enables individual bits to be set on a write. It is hardwired to specific values used during the auto-discovery process by an external debug agent.





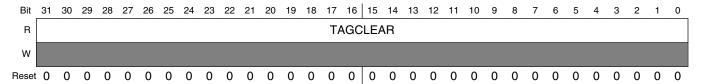
MTB_TAGSET field descriptions

Field	Description
TAGSET	TAGSET
	Hardwired to 0x0000_0000

32.3.1.7 Claim TAG Clear Register (MTB_TAGCLEAR)

The read/write Claim Tag Clear Register is used to read the claim status on debug resources. A read indicates the claim tag status. Writing 1 to a specific bit clears the corresponding claim tag to 0. It is hardwired to specific values used during the auto-discovery process by an external debug agent.

Address: F000_0000h base + FA4h offset = F000_0FA4h



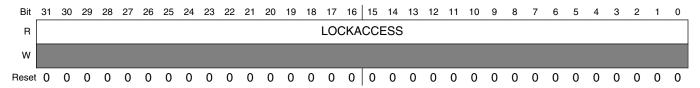
MTB_TAGCLEAR field descriptions

Field	Description
TAGCLEAR	TAGCLEAR
	Hardwired to 0x0000_0000

32.3.1.8 Lock Access Register (MTB_LOCKACCESS)

The Lock Access Register enables a write access to component registers. It is hardwired to specific values used during the auto-discovery process by an external debug agent.





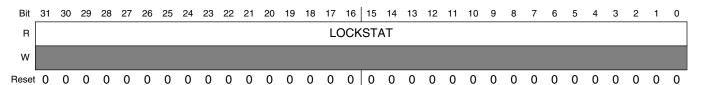
MTB_LOCKACCESS field descriptions

Field	Description
LOCKACCESS	Hardwired to 0x0000_0000

32.3.1.9 Lock Status Register (MTB_LOCKSTAT)

The Lock Status Register indicates the status of the lock control mechanism. This register is used in conjunction with the Lock Access Register. It is hardwired to specific values used during the auto-discovery process by an external debug agent.

Address: F000_0000h base + FB4h offset = F000_0FB4h



MTB_LOCKSTAT field descriptions

Field	Description
LOCKSTAT	LOCKSTAT
	Hardwired to 0x0000_0000

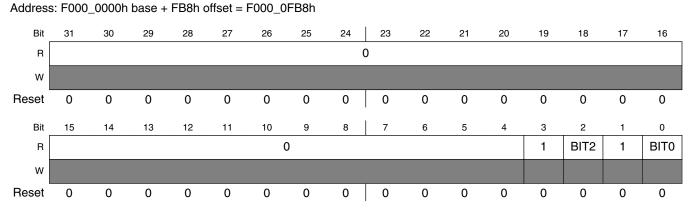
32.3.1.10 Authentication Status Register (MTB_AUTHSTAT)

The Authentication Status Register reports the required security level and current status of the security enable bit pairs. Where functionality changes on a given security level, this change must be reported in this register. It is connected to specific signals used during the auto-discovery process by an external debug agent.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Memory map and register definition

MTB_AUTHSTAT[3:2] indicates if nonsecure, noninvasive debug is enabled or disabled, while MTB_AUTHSTAT[1:0] indicates the enabled/disabled state of nonsecure, invasive debug. For both 2-bit fields, 0b10 indicates the functionality is disabled and 0b11 indicates it is enabled.



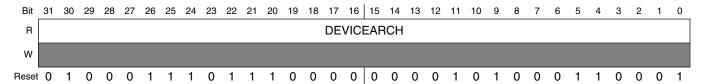
MTB_AUTHSTAT field descriptions

Field	Description
31–4	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
3	BIT3
Reserved	
	This read-only field is reserved and always has the value 1.
2	BIT2
BIT2	
	Connected to NIDEN or DBGEN signal.
1	BIT1
Reserved	
	This read-only field is reserved and always has the value 1.
0	Connected to DBGEN.
BIT0	

32.3.1.11 Device Architecture Register (MTB_DEVICEARCH)

This register indicates the device architecture. It is hardwired to specific values used during the auto-discovery process by an external debug agent.

Address: F000_0000h base + FBCh offset = F000_0FBCh



657

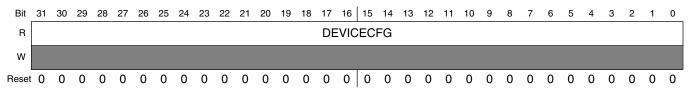
MTB_DEVICEARCH field descriptions

Field	Description
DEVICEARCH	DEVICEARCH
	Hardwired to 0x4770_0A31.

32.3.1.12 Device Configuration Register (MTB_DEVICECFG)

This register indicates the device configuration. It is hardwired to specific values used during the auto-discovery process by an external debug agent.





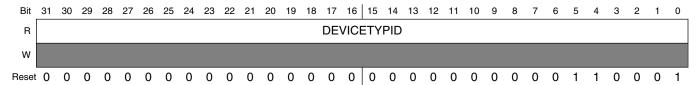
MTB_DEVICECFG field descriptions

Field	Description
DEVICECFG	DEVICECFG
	Hardwired to 0x0000_0000.

32.3.1.13 Device Type Identifier Register (MTB_DEVICETYPID)

This register indicates the device type ID. It is hardwired to specific values used during the auto-discovery process by an external debug agent.

Address: F000_0000h base + FCCh offset = F000_0FCCh



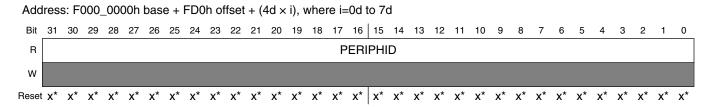
MTB_DEVICETYPID field descriptions

Field	Description
DEVICETYPID	DEVICETYPID
	Hardwired to 0x0000_0031.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Peripheral ID Register (MTB PERIPHIDn) 32.3.1.14

These registers indicate the peripheral IDs. They are hardwired to specific values used during the auto-discovery process by an external debug agent.

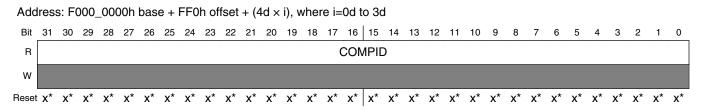


MTB_PERIPHIDn field descriptions

Field	Description
PERIPHID	PERIPHID
	Peripheral ID4 is hardwired to 0x0000_0004; ID0 to 0x0000_0032; ID1 to 0x0000_00B9; ID2 to 0x0000_001B; and all the others to 0x0000_0000.

Component ID Register (MTB COMPIDn) 32.3.1.15

These registers indicate the component IDs. They are hardwired to specific values used during the auto-discovery process by an external debug agent.



MTB COMPIDn field descriptions

Field	Description
COMPID	Component ID Component ID0 is hardwired to 0x0000_000D; ID1 to 0x0000_0090; ID2 to 0x0000_0005; ID3 to 0x0000_00B1.

MTB_DWT Memory Map 32.3.2

The MTB_DWT programming model supports a very simplified subset of the v7M debug architecture and follows the standard Arm DWT definition.

658

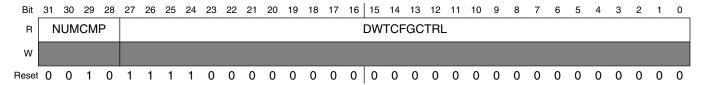
MTBDWT memory map

Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page
F000_1000	MTB DWT Control Register (MTBDWT_CTRL)	32	R	2F00_0000h	32.3.2.1/ 660
F000_1020	MTB_DWT Comparator Register (MTBDWT_COMP0)	32	R/W	0000_0000h	32.3.2.2/ 661
F000_1024	MTB_DWT Comparator Mask Register (MTBDWT_MASK0)	32	R/W	0000_0000h	32.3.2.3/ 661
F000_1028	MTB_DWT Comparator Function Register 0 (MTBDWT_FCT0)	32	R/W	0000_0000h	32.3.2.4/ 662
F000_1030	MTB_DWT Comparator Register (MTBDWT_COMP1)	32	R/W	0000_0000h	32.3.2.2/ 661
F000_1034	MTB_DWT Comparator Mask Register (MTBDWT_MASK1)	32	R/W	0000_0000h	32.3.2.3/ 661
F000_1038	MTB_DWT Comparator Function Register 1 (MTBDWT_FCT1)	32	R/W	0000_0000h	32.3.2.5/ 664
F000_1200	MTB_DWT Trace Buffer Control Register (MTBDWT_TBCTRL)	32	R/W	2000_0000h	32.3.2.6/ 665
F000_1FC8	Device Configuration Register (MTBDWT_DEVICECFG)	32	R	0000_0000h	32.3.2.7/ 667
F000_1FCC	Device Type Identifier Register (MTBDWT_DEVICETYPID)	32	R	0000_0004h	32.3.2.8/ 667
F000_1FD0	Peripheral ID Register (MTBDWT_PERIPHID4)	32	R	See section	32.3.2.9/ 668
F000_1FD4	Peripheral ID Register (MTBDWT_PERIPHID5)	32	R	See section	32.3.2.9/ 668
F000_1FD8	Peripheral ID Register (MTBDWT_PERIPHID6)	32	R	See section	32.3.2.9/ 668
F000_1FDC	Peripheral ID Register (MTBDWT_PERIPHID7)	32	R	See section	32.3.2.9/ 668
F000_1FE0	Peripheral ID Register (MTBDWT_PERIPHID0)	32	R	See section	32.3.2.9/ 668
F000_1FE4	Peripheral ID Register (MTBDWT_PERIPHID1)	32	R	See section	32.3.2.9/ 668
F000_1FE8	Peripheral ID Register (MTBDWT_PERIPHID2)	32	R	See section	32.3.2.9/ 668
F000_1FEC	Peripheral ID Register (MTBDWT_PERIPHID3)	32	R	See section	32.3.2.9/ 668
F000_1FF0	Component ID Register (MTBDWT_COMPID0)	32	R	See section	32.3.2.10/ 668
F000_1FF4	Component ID Register (MTBDWT_COMPID1)	32	R	See section	32.3.2.10/ 668
F000_1FF8	Component ID Register (MTBDWT_COMPID2)	32	R	See section	32.3.2.10/ 668
F000_1FFC	Component ID Register (MTBDWT_COMPID3)	32	R	See section	32.3.2.10/ 668

32.3.2.1 MTB DWT Control Register (MTBDWT_CTRL)

The MTBDWT_CTRL register provides read-only information on the watchpoint configuration for the MTB_DWT.

Address: F000_1000h base + 0h offset = F000_1000h



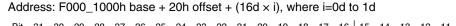
MTBDWT_CTRL field descriptions

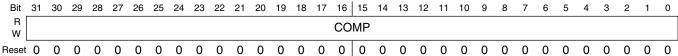
Field	Description
31–28 NUMCMP	Number of comparators
	The MTB_DWT implements two comparators.
DWTCFGCTRL	DWT configuration controls
	This field is hardwired to 0xF00_0000, disabling all the remaining DWT functionality. The specific fields and their state are:
	MTBDWT_CTRL[27] = NOTRCPKT = 1, trace sample and exception trace is not supported
	MTBDWT_CTRL[26] = NOEXTTRIG = 1, external match signals are not supported
	MTBDWT_CTRL[25] = NOCYCCNT = 1, cycle counter is not supported
	MTBDWT_CTRL[24] = NOPRFCNT = 1, profiling counters are not supported
	MTBDWT_CTRL[22] = CYCEBTENA = 0, no POSTCNT underflow packets generated
	MTBDWT_CTRL[21] = FOLDEVTENA = 0, no folded instruction counter overflow events
	MTBDWT_CTRL[20] = LSUEVTENA = 0, no LSU counter overflow events
	MTBDWT_CTRL[19] = SLEEPEVTENA = 0, no sleep counter overflow events
	MTBDWT_CTRL[18] = EXCEVTENA = 0, no exception overhead counter events
	MTBDWT_CTRL[17] = CPIEVTENA = 0, no CPI counter overflow events
	MTBDWT_CTRL[16] = EXCTRCENA = 0, generation of exception trace disabled
	MTBDWT_CTRL[12] = PCSAMPLENA = 0, no periodic PC sample packets generated
	MTBDWT_CTRL[11:10] = SYNCTAP = 0, no synchronization packets
	MTBDWT_CTRL[9] = CYCTAP = 0, cycle counter is not supported
	MTBDWT_CTRL[8:5] = POSTINIT = 0, cycle counter is not supported
	MTBDWT_CTRL[4:1] = POSTPRESET = 0, cycle counter is not supported
	MTBDWT_CTRL[0] = CYCCNTENA = 0, cycle counter is not supported

661

32.3.2.2 MTB_DWT Comparator Register (MTBDWT_COMPn)

The MTBDWT_COMPn registers provide the reference value for comparator n.





MTBDWT_COMPn field descriptions

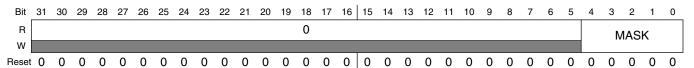
Field	Description
COMP	Reference value for comparison
	If MTBDWT_COMP0 is used for a data value comparator and the access size is byte or halfword, the data value must be replicated across all appropriate byte lanes of this register. For example, if the data is a byte-sized "x" value, then COMP[31:24] = COMP[23:16] = COMP[15:8] = COMP[7:0] = "x". Likewise, if the data is a halfword-size "y" value, then COMP[31:16] = COMP[15:0] = "y".

32.3.2.3 MTB_DWT Comparator Mask Register (MTBDWT_MASKn)

The MTBDWT_MASKn registers define the size of the ignore mask applied to the reference address for address range matching by comparator n. Note the format of this mask field is different than the MTB_MASTER[MASK].

Address: F000_1000h base + 24h offset + (16d × i), where i=0d to 1d

NXP Semiconductors



MTBDWT_MASK*n* field descriptions

Field	Description		
31–5 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.		
MASK	MASK		
	The value of the ignore mask, 0-31 bits, is applied to address range matching. MASK = 0 is used to include all bits of the address in the comparison, except if MASK = 0 and the comparator is configured to watch instruction fetch addresses, address bit [0] is ignored by the hardware since all fetches must be at least halfword aligned. For MASK != 0 and regardless of watch type, address bits [x-1:0] are ignored in the address comparison.		
	Using a mask means the comparator matches on a range of addresses, defined by the unmasked most significant bits of the address, bits [31:x]. The maximum MASK value is 24, producing a 16 Mbyte mask. An attempted write of a MASK value > 24 is limited by the MTBDWT hardware to 24.		

Table continues on the next page...

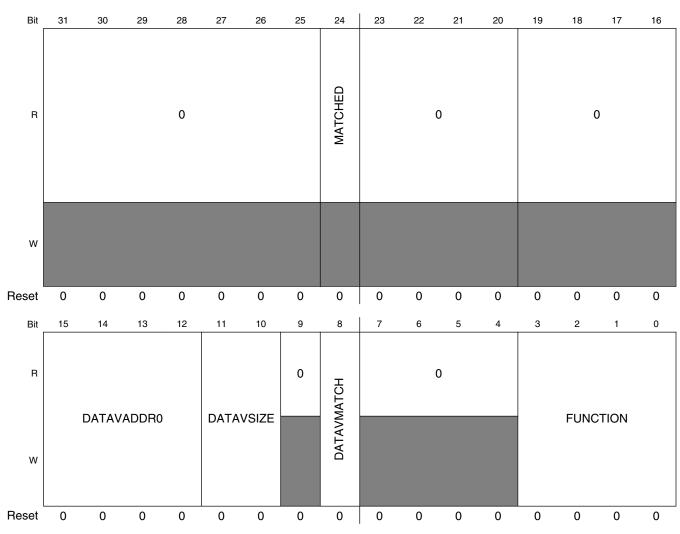
MTBDWT_MASK*n* field descriptions (continued)

Field	Description
	If MTBDWT_COMP0 is used as a data value comparator, then MTBDWT_MASK0 should be programmed to zero.

32.3.2.4 MTB_DWT Comparator Function Register 0 (MTBDWT_FCT0)

The MTBDWT_FCTn registers control the operation of comparator n.

Address: F000_1000h base + 28h offset = F000_1028h



MTBDWT_FCT0 field descriptions

Field	Description
31–25	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.

Table continues on the next page...

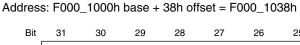
MTBDWT_FCT0 field descriptions (continued)

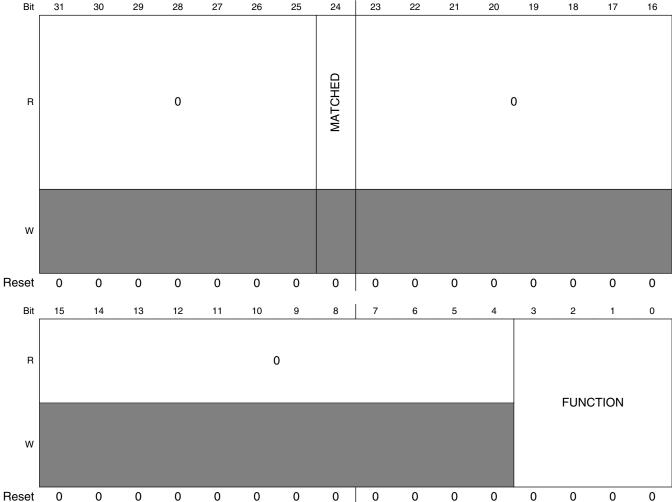
Field	Description
24 MATCHED	Comparator match
WIXTOTLES	If this read-only flag is asserted, it indicates the operation defined by the FUNCTION field occurred since the last read of the register. Reading the register clears this bit.
	0 No match.
	1 Match occurred.
23–20 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
19–16 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
15–12	Data Value Address 0
DATAVADDR0	Since the MTB_DWT implements two comparators, the DATAVADDR0 field is restricted to values {0,1}. When the DATAVMATCH bit is asserted, this field defines the comparator number to use for linked address comparison.
	If MTBDWT_COMP0 is used as a data watchpoint and MTBDWT_COMP1 as an address watchpoint, DATAVADDR0 must be set.
11–10	Data Value Size
DATAVSIZE	For data value matching, this field defines the size of the required data comparison.
	00 Byte.
	01 Halfword.
	10 Word.
_	11 Reserved. Any attempts to use this value results in UNPREDICTABLE behavior.
9 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
8	Data Value Match
DATAVMATCH	When this field is 1, it enables data value comparison. For this implementation, MTBDWT_COMP0 supports address or data value comparisons; MTBDWT_COMP1 only supports address comparisons.
	Perform address comparison. Perform data value comparison.
7–4	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
FUNCTION	Function
	Selects the action taken on a comparator match. If MTBDWT_COMP0 is used for a data value and MTBDWT_COMP1 for an address value, then MTBDWT_FCT1[FUNCTION] must be set to zero. For this configuration, MTBDWT_MASK1 can be set to a non-zero value, so the combined comparators match on a range of addresses.
	0000 Disabled.
	0100 Instruction fetch.
	0101 Data operand read.
	0110 Data operand write.
	Data operand (read + write).
	others Reserved. Any attempts to use this value results in UNPREDICTABLE behavior.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

32.3.2.5 MTB_DWT Comparator Function Register 1 (MTBDWT_FCT1)

The MTBDWT_FCTn registers control the operation of comparator n. Since the MTB_DWT only supports data value comparisons on comparator 0, there are several fields in the MTBDWT_FCT1 register that are RAZ/WI (bits 12, 11:10, 8).





MTBDWT_FCT1 field descriptions

Field	Description
31–25 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
	Comparator match If this read-only flag is asserted, it indicates the operation defined by the FUNCTION field occurred since the last read of the register. Reading the register clears this bit.

Table continues on the next page...

NXP Semiconductors

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

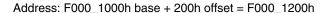
MTBDWT_FCT1 field descriptions (continued)

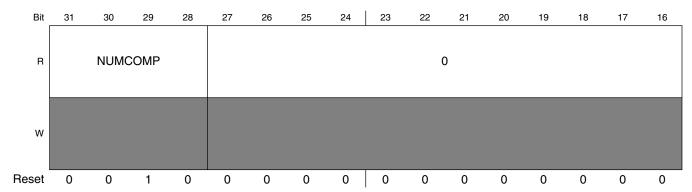
Field	Description		
	No match.		
	Match occurred.		
23–4	his field is reserved.		
Reserved	his read-only field is reserved and always has the value 0.		
FUNCTION	unction		
	Selects the action taken on a comparator match. If MTBDWT_COMP0 is used for a data value and MTBDWT_COMP1 for an address value, then MTBDWT_FCT1[FUNCTION] must be set to zero. For this onfiguration, MTBDWT_MASK1 can be set to a non-zero value, so the combined comparators match on range of addresses.		
	000 Disabled.		
	100 Instruction fetch.		
	101 Data operand read.		
	110 Data operand write.		
	1111 Data operand (read + write).		
	thers Reserved. Any attempts to use this value results in UNPREDICTABLE behavior.		

32.3.2.6 MTB_DWT Trace Buffer Control Register (MTBDWT_TBCTRL)

The MTBDWT_TBCTRL register defines how the watchpoint comparisons control the actual trace buffer operation.

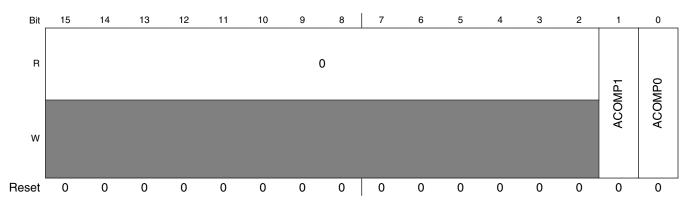
Recall the MTB supports starting and stopping the program trace based on the watchpoint comparisons signaled via TSTART and TSTOP. The watchpoint comparison signals are enabled in the MTB's control logic by setting the appropriate enable bits, MTB_MASTER[TSTARTEN, TSTOPEN]. In the event of simultaneous assertion of both TSTART and TSTOP, TSTART takes priority.





Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Memory map and register definition



MTBDWT_TBCTRL field descriptions

Field	Description
31–28 NUMCOMP	Number of Comparators This read-only field specifies the number of comparators in the MTB_DWT. This implementation includes two registers.
27–2 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
1 ACOMP1	Action based on Comparator 1 match When the MTBDWT_FCT1[MATCHED] is set, it indicates MTBDWT_COMP1 address compare has triggered and the trace buffer's recording state is changed. O Trigger TSTOP based on the assertion of MTBDWT_FCT1[MATCHED]. Trigger TSTART based on the assertion of MTBDWT_FCT1[MATCHED].
0 ACOMP0	Action based on Comparator 0 match When the MTBDWT_FCT0[MATCHED] is set, it indicates MTBDWT_COMP0 address compare has triggered and the trace buffer's recording state is changed. The assertion of MTBDWT_FCT0[MATCHED] is caused by the following conditions: • Address match in MTBDWT_COMP0 when MTBDWT_FCT0[DATAVMATCH] = 0 • Data match in MTBDWT_COMP0 when MTBDWT_FCT0[DATAVMATCH, DATAVADDR0] = {1,0} • Data match in MTBDWT_COMP0 and address match in MTBDWT_COMP1 when MTBDWT_FCT0[DATAVMATCH, DATAVADDR0] = {1,1} 0 Trigger TSTOP based on the assertion of MTBDWT_FCT0[MATCHED]. 1 Trigger TSTART based on the assertion of MTBDWT_FCT0[MATCHED].

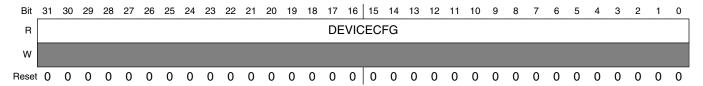
Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

667

32.3.2.7 Device Configuration Register (MTBDWT_DEVICECFG)

This register indicates the device configuration. It is hardwired to specific values used during the auto-discovery process by an external debug agent.





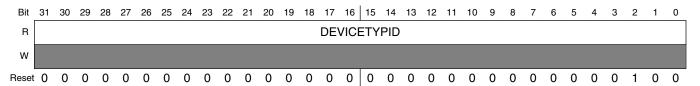
MTBDWT_DEVICECFG field descriptions

Field	Description
DEVICECFG	DEVICECFG
	Hardwired to 0x0000_0000.

32.3.2.8 Device Type Identifier Register (MTBDWT_DEVICETYPID)

This register indicates the device type ID. It is hardwired to specific values used during the auto-discovery process by an external debug agent.

Address: F000_1000h base + FCCh offset = F000_1FCCh

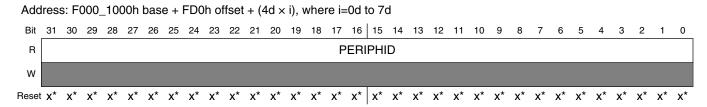


MTBDWT_DEVICETYPID field descriptions

Field	Description
DEVICETYPID	DEVICETYPID
	Hardwired to 0x0000_0004.

32.3.2.9 Peripheral ID Register (MTBDWT_PERIPHIDn)

These registers indicate the peripheral IDs. They are hardwired to specific values used during the auto-discovery process by an external debug agent.

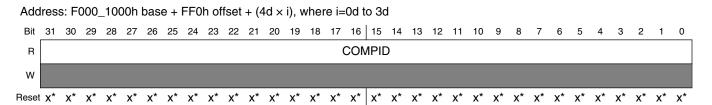


MTBDWT_PERIPHIDn field descriptions

Field	Description
PERIPHID	PERIPHID
	Peripheral ID1 is hardwired to 0x0000_00E0; ID2 to 0x0000_0008; and all the others to 0x0000_0000.

32.3.2.10 Component ID Register (MTBDWT_COMPIDn)

These registers indicate the component IDs. They are hardwired to specific values used during the auto-discovery process by an external debug agent.



MTBDWT_COMPIDn field descriptions

Field	Description
	Component ID Component ID0 is hardwired to 0x0000_000D; ID1 to 0x0000_0090; ID2 to 0x0000_0005; ID3 to 0x0000_00B1.

32.3.3 System ROM Memory Map

The System ROM Table registers are also mapped into a sparsely-populated 4 KB address space.

For core configurations like that supported by Cortex-M0+, Arm recommends that a debugger identifies and connects to the debug components using the CoreSight debug infrastructure.

Arm recommends that a debugger follows the flow as shown in the following figure to discover the components in the CoreSight debug infrastructure. In this case, a debugger reads the peripheral and component ID registers for each CoreSight component in the CoreSight system.

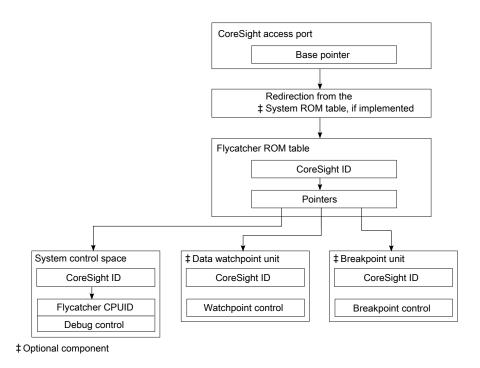


Figure 32-3. CoreSight discovery process

ROM memory map

Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page
F000_2000	Entry (ROM_ENTRY0)	32	R	See section	32.3.3.1/ 670
F000_2004	Entry (ROM_ENTRY1)	32	R	See section	32.3.3.1/ 670
F000_2008	Entry (ROM_ENTRY2)	32	R	See section	32.3.3.1/ 670
F000_200C	End of Table Marker Register (ROM_TABLEMARK)	32	R	0000_0000h	32.3.3.2/ 671
F000_2FCC	System Access Register (ROM_SYSACCESS)	32	R	0000_0001h	32.3.3.3/ 671
F000_2FD0	Peripheral ID Register (ROM_PERIPHID4)	32	R	See section	32.3.3.4/ 672

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

ROM memory map (continued)

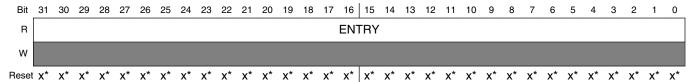
Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page
F000_2FD4	Peripheral ID Register (ROM_PERIPHID5)	32	R	See section	32.3.3.4/ 672
F000_2FD8	Peripheral ID Register (ROM_PERIPHID6)	32	R	See section	32.3.3.4/ 672
F000_2FDC	Peripheral ID Register (ROM_PERIPHID7)	32	R	See section	32.3.3.4/ 672
F000_2FE0	Peripheral ID Register (ROM_PERIPHID0)	32	R	See section	32.3.3.4/ 672
F000_2FE4	Peripheral ID Register (ROM_PERIPHID1)	32	R	See section	32.3.3.4/ 672
F000_2FE8	Peripheral ID Register (ROM_PERIPHID2)	32	R	See section	32.3.3.4/ 672
F000_2FEC	Peripheral ID Register (ROM_PERIPHID3)	32	R	See section	32.3.3.4/ 672
F000_2FF0	Component ID Register (ROM_COMPID0)	32	R	See section	32.3.3.5/ 672
F000_2FF4	Component ID Register (ROM_COMPID1)	32	R	See section	32.3.3.5/ 672
F000_2FF8	Component ID Register (ROM_COMPID2)	32	R	See section	32.3.3.5/ 672
F000_2FFC	Component ID Register (ROM_COMPID3)	32	R	See section	32.3.3.5/ 672

32.3.3.1 Entry (ROM_ENTRY*n*)

The System ROM Table begins with "n" relative 32-bit addresses, one for each debug component present in the device and terminating with an all-zero value signaling the end of the table at the "n+1"-th value.

It is hardwired to specific values used during the auto-discovery process by an external debug agent.

Address: F000_2000h base + 0h offset + $(4d \times i)$, where i=0d to 2d



ROM_ENTRYn field descriptions

Field	Description
ENTRY	ENTRY

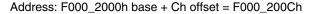
Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

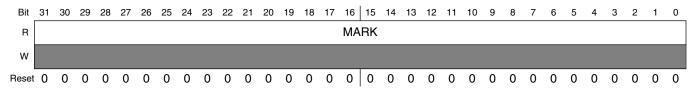
ROM_ENTRY*n* field descriptions (continued)

Field	Description
	Entry 0 (MTB) is hardwired to 0xFFFF_E003; Entry 1 (MTBDWT) to 0xFFFF_F003; Entry 2 (CM0+ ROM Table) to 0xF00F_D003.

32.3.3.2 End of Table Marker Register (ROM_TABLEMARK)

This register indicates end of table marker. It is hardwired to specific values used during the auto-discovery process by an external debug agent.





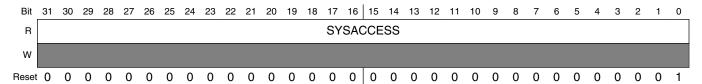
ROM_TABLEMARK field descriptions

Field	Description
MARK	MARK
	Hardwired to 0x0000_0000

32.3.3.3 System Access Register (ROM_SYSACCESS)

This register indicates system access. It is hardwired to specific values used during the auto-discovery process by an external debug agent.

Address: F000_2000h base + FCCh offset = F000_2FCCh



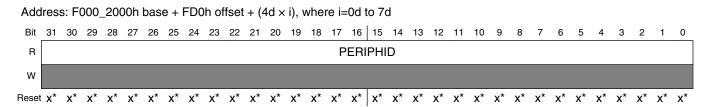
ROM_SYSACCESS field descriptions

Field	Description
SYSACCESS	SYSACCESS
	Hardwired to 0x0000_0001

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

32.3.3.4 Peripheral ID Register (ROM_PERIPHID*n*)

These registers indicate the peripheral IDs. They are hardwired to specific values used during the auto-discovery process by an external debug agent.

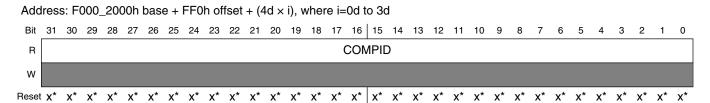


ROM_PERIPHID*n* field descriptions

Field	Description
PERIPHID	PERIPHID
	Peripheral ID1 is hardwired to 0x0000_00E0; ID2 to 0x0000_0008; and all the others to 0x0000_0000.

32.3.3.5 Component ID Register (ROM_COMPIDn)

These registers indicate the component IDs. They are hardwired to specific values used during the auto-discovery process by an external debug agent.



ROM_COMPIDn field descriptions

Field	Description
	Component ID Component ID0 is hardwired to 0x0000_000D; ID1 to 0x0000_0010; ID2 to 0x0000_0005; ID3 to 0x0000_00B1.

32.4 Usage Guide

32.4.1 ARM reference

For more information about MTB, please refer to the ARM document ARM Debug Interface Architecture Specification .

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Usage Guide

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Chapter 33 Signal Multiplexing and Pin Assignment

33.1 Introduction

To optimize functionality in small packages, pins have several functions available via signal multiplexing. This chapter illustrates which of the device's signals are multiplexed on which external pin.

The Port Control block controls which signal is present on the external pin. Refer to that chapter to find which register controls the operation of a specific pin.

33.2 Pinouts

33.2.1 KE1xZ Signal Multiplexing and Pin Assignments

The following table shows the signals available on each pin and the locations of these pins on the devices. The Port Control Module is responsible for selecting which ALT functionality is available on each pin.

NOTE

On this device, there are several special ADC channels which support hardware interleave between multiple ADCs. Taking ADC0_SE4 and ADC1_SE14 channels as an example, these two channels can work independently, but they can also be hardware interleaved. In the hardware interleaved mode, a signal on the pin PTB0 can be sampled by both ADC0 and ADC1. The interleaved mode is enabled by SIM_CHIPCTL[ADC_INTERLEAVE_EN] bits. For more information, see "ADC Hardware Interleaved Channels" in the ADC chapter of Reference Manual.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Pinouts

100 LQFP	64 LQFP	Pin Name	Default	ALT0	ALT1	ALT2	ALT3	ALT4	ALT5	ALT6	ALT7
-	10	VREFL/ VSS	VREFL/ VSS	VREFL/ VSS							
1	-	PTE16	DISABLED		PTE16					FXIO_D3	TRGMUX_ OUT7
2	-	PTE15	DISABLED		PTE15					FXIO_D2	TRGMUX_ OUT6
3	1	PTD1	TSI0_CH5	TSI0_CH5	PTD1	FTM0_CH3	LPSPI1_SIN	FTM2_CH1		FXIO_D1	TRGMUX_ OUT2
4	2	PTD0	TSI0_CH4	TSI0_CH4	PTD0	FTM0_CH2	LPSPI1_SCK	FTM2_CH0		FXIO_D0	TRGMUX_ OUT1
5	3	PTE11	TSI0_CH3	TSI0_CH3	PTE11	PWT_IN1	LPTMR0_ALT1			FXIO_D5	TRGMUX_ OUT5
6	4	PTE10	TSI0_CH2	TSI0_CH2	PTE10	CLKOUT				FXIO_D4	TRGMUX_ OUT4
7	_	PTE13	DISABLED		PTE13						
8	5	PTE5	TSI0_CH0	TSI0_CH0	PTE5	TCLK2	FTM2_QD_ PHA	FTM2_CH3		FXIO_D7	EWM_IN
9	6	PTE4	TSI0_CH1	TSI0_CH1	PTE4	BUSOUT	FTM2_QD_ PHB	FTM2_CH2		FXIO_D6	EWM_OUT_b
10	7	VDD	VDD	VDD							
11	8	VDDA	VDDA	VDDA							
12	9	VREFH	VREFH	VREFH							
13	_	VREFL	VREFL	VREFL							
14	_	VSS	VSS	VSS							
15	11	PTB7	EXTAL	EXTAL	PTB7	LPI2C0_SCL					
16	12	PTB6	XTAL	XTAL	PTB6	LPI2C0_SDA					
17	_	PTE14	DISABLED		PTE14	FTM0_FLT1					
18	13	PTE3	TSI0_CH24	TSI0_CH24	PTE3	FTM0_FLT0	LPUART2_ RTS			TRGMUX_IN6	
19	_	PTE12	DISABLED		PTE12	FTM0_FLT3	LPUART2_TX				
20	_	PTD17	DISABLED		PTD17	FTM0_FLT2	LPUART2_RX				
21	14	PTD16	DISABLED		PTD16	FTM0_CH1					
22	15	PTD15	DISABLED		PTD15	FTM0_CH0					
23	16	PTE9	DAC0_OUT	DAC0_OUT	PTE9	FTM0_CH7	LPUART2_ CTS				
24	_	PTD14	DISABLED		PTD14						CLKOUT
25	-	PTD13	DISABLED		PTD13						RTC_CLKOUT
26	17	PTE8	ACMP0_IN3/ TSI0_CH11	ACMP0_IN3/ TSI0_CH11	PTE8	FTM0_CH6					
27	18	PTB5	TSI0_CH9	TSI0_CH9	PTB5	FTM0_CH5	LPSPI0_PCS1			TRGMUX_IN0	ACMP1_OUT
28	19	PTB4	ACMP1_IN2/ TSI0_CH8	ACMP1_IN2/ TSI0_CH8	PTB4	FTM0_CH4	LPSPI0_SOUT			TRGMUX_IN1	
29	20	PTC3	ADC0_SE11/ ACMP0_IN4/ EXTAL32	ADC0_SE11/ ACMP0_IN4/ EXTAL32	PTC3	FTM0_CH3					

Chapter 33 Signal Multiplexing and Pin Assignment

100 LQFP	64 LQFP	Pin Name	Default	ALT0	ALT1	ALT2	ALT3	ALT4	ALT5	ALT6	ALT7
30	21	PTC2	ADC0_SE10/ ACMP0_IN5/ XTAL32	ADC0_SE10/ ACMP0_IN5/ XTAL32	PTC2	FTM0_CH2					
31	22	PTD7	TSI0_CH10	TSI0_CH10	PTD7	LPUART2_TX		FTM2_FLT3			
32	23	PTD6	TSI0_CH7	TSI0_CH7	PTD6	LPUART2_RX		FTM2_FLT2			
33	24	PTD5	TSI0_CH6	TSI0_CH6	PTD5	FTM2_CH3	LPTMR0_ALT2		PWT_IN2	TRGMUX_IN7	
34	_	PTD12	DISABLED		PTD12	FTM2_CH2	LPI2C1_HREQ			LPUART2_ RTS	
35	_	PTD11	DISABLED		PTD11	FTM2_CH1	FTM2_QD_ PHA			LPUART2_ CTS	
36	_	PTD10	DISABLED		PTD10	FTM2_CH0	FTM2_QD_ PHB				
37	_	VSS	VSS	VSS							
38	_	VDD	VDD	VDD							
39	25	PTC1	ADC0_SE9/ ACMP1_IN3/ TSI0_CH23	ADC0_SE9/ ACMP1_IN3/ TSI0_CH23	PTC1	FTM0_CH1					
40	26	PTC0	ADC0_SE8/ ACMP1_IN4/ TSI0_CH22	ADC0_SE8/ ACMP1_IN4/ TSI0_CH22	PTC0	FTM0_CH0					
41	_	PTD9	ACMP1_IN5	ACMP1_IN5	PTD9	LPI2C1_SCL		FTM2_FLT3			
42	_	PTD8	DISABLED		PTD8	LPI2C1_SDA		FTM2_FLT2			
43	27	PTC17	ADC0_SE15	ADC0_SE15	PTC17	FTM1_FLT3		LPI2C1_SCLS			
44	28	PTC16	ADC0_SE14	ADC0_SE14	PTC16	FTM1_FLT2		LPI2C1_SDAS			
45	29	PTC15	ADC0_SE13	ADC0_SE13	PTC15	FTM1_CH3					
46	30	PTC14	ADC0_SE12	ADC0_SE12	PTC14	FTM1_CH2					
47	31	PTB3	ADC0_SE7/ TSI0_CH21	ADC0_SE7/ TSI0_CH21	PTB3	FTM1_CH1	LPSPI0_SIN	FTM1_QD_ PHA		TRGMUX_IN2	
48	32	PTB2	ADC0_SE6/ TSI0_CH20	ADC0_SE6/ TSI0_CH20	PTB2	FTM1_CH0	LPSPI0_SCK	FTM1_QD_ PHB		TRGMUX_IN3	
49	_	PTC13	DISABLED		PTC13						
50	_	PTC12	DISABLED		PTC12						
51	_	PTC11	DISABLED		PTC11						
52	_	PTC10	DISABLED		PTC10						
53	33	PTB1	ADC0_SE5	ADC0_SE5	PTB1	LPUARTO_TX	LPSPI0_SOUT	TCLK0			
54	34	PTB0	ADC0_SE4	ADC0_SE4	PTB0	LPUARTO_RX	LPSPI0_PCS0	LPTMR0_ALT3	PWT_IN3		
55	35	PTC9	DISABLED		PTC9	LPUART1_TX				LPUARTO_ RTS	
56	36	PTC8	DISABLED		PTC8	LPUART1_RX				LPUARTO_ CTS	
57	37	PTA7	ADC0_SE3/ ACMP1_IN1	ADC0_SE3/ ACMP1_IN1	PTA7	FTM0_FLT2		RTC_CLKIN		LPUART1_ RTS	
58	38	PTA6	ADC0_SE2/ ACMP1_IN0	ADC0_SE2/ ACMP1_IN0	PTA6	FTM0_FLT1	LPSPI1_PCS1			LPUART1_ CTS	
59	39	PTE7	DISABLED		PTE7	FTM0_CH7					

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Pinouts

100 LQFP	64 LQFP	Pin Name	Default	ALT0	ALT1	ALT2	ALT3	ALT4	ALT5	ALT6	ALT7
60	40	VSS	VSS	VSS							
61	41	VDD	VDD	VDD							
62	_	PTA17	DISABLED		PTA17	FTM0_CH6		EWM_OUT_b			
63	_	PTB17	DISABLED		PTB17	FTM0_CH5	LPSPI1_PCS3				
64	_	PTB16	DISABLED		PTB16	FTM0_CH4	LPSPI1_SOUT				
65	_	PTB15	DISABLED		PTB15	FTM0_CH3	LPSPI1_SIN				
66	_	PTB14	ADC1_SE9	ADC1_SE9	PTB14	FTM0_CH2	LPSPI1_SCK				
67	42	PTB13	ADC1_SE8	ADC1_SE8	PTB13	FTM0_CH1					
68	43	PTB12	ADC1_SE7	ADC1_SE7	PTB12	FTM0_CH0					
69	44	PTD4	ADC1_SE6	ADC1_SE6	PTD4	FTM0_FLT3					
70	45	PTD3	NMI_b	ADC1_SE3	PTD3		LPSPI1_PCS0	FXIO_D5		TRGMUX_IN4	NMI_b
71	46	PTD2	ADC1_SE2	ADC1_SE2	PTD2		LPSPI1_SOUT	FXIO_D4		TRGMUX_IN5	
72	47	PTA3	ADC1_SE1	ADC1_SE1	PTA3		LPI2C0_SCL	EWM_IN		LPUARTO_TX	
73	48	PTA2	ADC1_SE0	ADC1_SE0	PTA2		LPI2C0_SDA	EWM_OUT_b		LPUARTO_RX	
74	1	PTB11	DISABLED		PTB11		LPI2C0_HREQ				
75	1	PTB10	DISABLED		PTB10		LPI2C0_SDAS				
76	-	PTB9	DISABLED		PTB9		LPI2C0_SCLS				
77	1	PTB8	DISABLED		PTB8						
78	49	PTA1	ADC0_SE1/ ACMP0_IN1/ TSI0_CH18	ADC0_SE1/ ACMP0_IN1/ TSI0_CH18	PTA1	FTM1_CH1	LPI2CO_SDAS	FXIO_D3	FTM1_QD_ PHA	LPUARTO_ RTS	TRGMUX_ OUT0
79	50	PTA0	ADC0_SE0/ ACMP0_IN0/ TSI0_CH17	ADC0_SE0/ ACMP0_IN0/ TSI0_CH17	PTA0	FTM2_CH1	LPI2CO_SCLS	FXIO_D2	FTM2_QD_ PHA	LPUARTO_ CTS	TRGMUX_ OUT3
80	51	PTC7	ADC1_SE5/ TSI0_CH16	ADC1_SE5/ TSI0_CH16	PTC7	LPUART1_TX					
81	52	PTC6	ADC1_SE4/ TSI0_CH15	ADC1_SE4/ TSI0_CH15	PTC6	LPUART1_RX					
82	_	PTA16	DISABLED		PTA16	FTM1_CH3	LPSPI1_PCS2				
83	1	PTA15	DISABLED		PTA15	FTM1_CH2	LPSPI0_PCS3				
84	53	PTE6	ADC1_SE11	ADC1_SE11	PTE6	LPSPI0_PCS2				LPUART1_ RTS	
85	54	PTE2	ADC1_SE10/ TSI0_CH19	ADC1_SE10/ TSI0_CH19	PTE2	LPSPI0_SOUT	LPTMR0_ALT3		PWT_IN3	LPUART1_ CTS	
86	-	VSS	VSS	VSS							
87	ı	VDD	VDD	VDD							
88	ı	PTA14	DISABLED		PTA14	FTM0_FLT0		EWM_IN			BUSOUT
89	55	PTA13	DISABLED		PTA13			LPI2C1_SCLS			
90	56	PTA12	DISABLED		PTA12			LPI2C1_SDAS			
91	57	PTA11	DISABLED		PTA11		LPUARTO_RX	FXIO_D1			
92	58	PTA10	DISABLED		PTA10		LPUARTO_TX	FXIO_D0			
93	59	PTE1	TSI0_CH14	TSI0_CH14	PTE1	LPSPI0_SIN	LPI2C0_HREQ	LPI2C1_SCL			
94	60	PTE0	TSI0_CH13	TSI0_CH13	PTE0	LPSPI0_SCK	TCLK1	LPI2C1_SDA		FTM1_FLT2	

679

100 LQFP	64 LQFP	Pin Name	Default	ALT0	ALT1	ALT2	ALT3	ALT4	ALT5	ALT6	ALT7
-		DTO	T010 01110	T010 01110	DT0-	FT.10 0110	DTO OLIVOUT	I DIOCA LIDEO		FT140 0D	
95	61	PTC5	TSI0_CH12	TSI0_CH12	PTC5	FTM2_CH0	RTC_CLKOUT	LPI2C1_HREQ		FTM2_QD_ PHB	
96	62	PTC4	SWD_CLK	ACMP0_IN2	PTC4	FTM1_CH0	RTC_CLKOUT		EWM_IN	FTM1_QD_ PHB	SWD_CLK
97	63	PTA5	RESET_b		PTA5		TCLK1				RESET_b
98	64	PTA4	SWD_DIO		PTA4			ACMP0_OUT	EWM_OUT_b		SWD_DIO
99	1	PTA9	DISABLED		PTA9			FXIO_D7		FTM1_FLT3	
100	ı	PTA8	DISABLED		PTA8			FXIO_D6			

33.2.2 Pin properties

NOTE

For some pins, for example UART RXD, I2C SDA and SCL, they can be configure as pesudo opendrain pins via its module itself or the SIM module. Please see the respective module chapter and Port control and interrupt module features for details.

100 LQFP	64 LQFP	Pin Name	Driver strength	Default status after POR	Pullup/ pulldown setting after POR	Slew rate after POR	Passive pin filter after POR	True Open Drain	Pin interrupt
1		PTE16	ND	Hi-Z	_	_	_	_	Υ
2		PTE15	ND	Hi-Z	_	_	_	_	Υ
3	1	PTD1	HD	Hi-Z	_	_	_	_	Υ
4	2	PTD0	HD	Hi-Z	_	_	_	_	Υ
5	3	PTE11	ND	Hi-Z	_	_	_	_	Υ
6	4	PTE10	ND	Hi-Z	_	_	_	_	Υ
7		PTE13	ND	Hi-Z	_	_	_	_	Υ
8	5	PTE5	ND	Hi-Z	_	_	_	_	Υ
9	6	PTE4	ND	Hi-Z	_	_	_	_	Υ
10	7	VDD	_	_	_	_	_	_	_
11	8	VDDA	_	_	_	_	_	_	_
12	9	VREFH	_	_	_	_	_	_	_
13	10	VREFL	_	_	_	_	_	_	_
14		VSS	_	_	_	_	_	_	_
15	11	PTB7	ND	Hi-Z	_	_	_	_	Υ
16	12	PTB6	ND	Hi-Z	_	_	_	_	Υ
17		PTE14	ND	Hi-Z	_	_	_	_	Υ
18	13	PTE3	ND	Hi-Z	_	_	_	_	Υ
19		PTE12	ND	Hi-Z					Υ

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Pinouts

100 LQFP	64 LQFP	Pin Name	Driver strength	Default status after POR	Pullup/ pulldown setting after POR	Slew rate after POR	Passive pin filter after POR	True Open Drain	Pin interrupt
20		PTD17	ND	Hi-Z	_	_	_	_	Υ
21	14	PTD16	HD	Hi-Z	_	_	_	_	Υ
22	15	PTD15	HD	Hi-Z	_	_	_	_	Υ
23	16	PTE9	ND	Hi-Z	_	_	_	_	Υ
24		PTD14	ND	Hi-Z	_	_	_	_	Υ
25		PTD13	ND	Hi-Z	_	_	_	_	Υ
26	17	PTE8	ND	Hi-Z	_	_	_	_	Υ
27	18	PTB5	HD	Hi-Z	_	_	_	_	Υ
28	19	PTB4	HD	Hi-Z	_	_	_	_	Υ
29	20	PTC3	ND	Hi-Z	_	_	_	_	Υ
30	21	PTC2	ND	Hi-Z	_	_	_	_	Υ
31	22	PTD7	ND	Hi-Z	_	_	_	_	Υ
32	23	PTD6	ND	Hi-Z	_	_	_	_	Υ
33	24	PTD5	ND	Hi-Z	_	_	_	_	Υ
34		PTD12	ND	Hi-Z	_	_	_	_	Υ
35		PTD11	ND	Hi-Z	_	_	_	_	Υ
36		PTD10	ND	Hi-Z	_	_	_	_	Υ
37		vss	_	_	_	_	_	_	_
38		VDD	_	_	_	_	_	_	_
39	25	PTC1	ND	Hi-Z	_	_	_	_	Υ
40	26	PTC0	ND	Hi-Z	_	_	_	_	Υ
41		PTD9	ND	Hi-Z	_	_	_	_	Υ
42		PTD8	ND	Hi-Z	_	_	_	_	Υ
43	27	PTC17	ND	Hi-Z	_	_	_	_	Υ
44	28	PTC16	ND	Hi-Z	_	_	_	_	Υ
45	29	PTC15	ND	Hi-Z	_	_	_	_	Υ
46	30	PTC14	ND	Hi-Z	_	_	_	_	Υ
47	31	РТВ3	ND	Hi-Z	_	_	_	_	Υ
48	32	PTB2	ND	Hi-Z	_	_	_	_	Υ
49		PTC13	ND	Hi-Z	_	_	_	_	Υ
50		PTC12	ND	Hi-Z	_	_	_	_	Υ
51		PTC11	ND	Hi-Z	_	_	_	_	Υ
52		PTC10	ND	Hi-Z	_	_	_	_	Υ
53	33	PTB1	ND	Hi-Z	_	_	_	_	Υ
54	34	РТВ0	ND	Hi-Z	_	_	_	_	Υ
55	35	PTC9	ND	Hi-Z	_	_	_	_	Υ
56	36	PTC8	ND	Hi-Z	_	_	_	_	Υ
57	37	PTA7	ND	Hi-Z	_	_	_	_	Υ

Table continues on the next page...

100 LQFP	64 LQFP	Pin Name	Driver strength	Default status after POR	Pullup/ pulldown setting after POR	Slew rate after POR	Passive pin filter after POR	True Open Drain	Pin interrupt
58	38	PTA6	ND	Hi-Z	_	_	_	_	Υ
59	39	PTE7	ND	Hi-Z	_	_	_	_	Υ
60	40	VSS	_	_	_	_	_	_	_
61	41	VDD	_	_	_	_	_	_	_
62		PTA17	ND	Hi-Z	_	_	_	_	Υ
63		PTB17	ND	Hi-Z	_	_	_	_	Υ
64		PTB16	ND	Hi-Z	_	_	_	_	Υ
65		PTB15	ND	Hi-Z	_	_	_	_	Υ
66		PTB14	ND	Hi-Z	_	_	_	_	Υ
67	42	PTB13	ND	Hi-Z	_	_	_	_	Υ
68	43	PTB12	ND	Hi-Z	_	_	_	_	Υ
69	44	PTD4	ND	Hi-Z	_	_	_	_	Υ
70	45	PTD3	ND	Н	PU	_	N	_	Υ
71	46	PTD2	ND	Hi-Z	_	_	_	_	Υ
72	47	PTA3	ND	Hi-Z	_	_	_	_	Υ
73	48	PTA2	ND	Hi-Z	_	_	_	_	Υ
74		PTB11	ND	Hi-Z	_	_	_	_	Υ
75		PTB10	ND	Hi-Z	_	_	_	_	Υ
76		PTB9	ND	Hi-Z	_	_	_	_	Υ
77		PTB8	ND	Hi-Z	_	_	_	_	Υ
78	49	PTA1	ND	Hi-Z	_	_	_	_	Υ
79	50	PTA0	ND	Hi-Z	_	_	_	_	Υ
80	51	PTC7	ND	Hi-Z	_	_	_	_	Υ
81	52	PTC6	ND	Hi-Z	_	_	_	_	Υ
82		PTA16	ND	Hi-Z	_	_	_	_	Υ
83		PTA15	ND	Hi-Z	_	_	_	_	Υ
84	53	PTE6	ND	Hi-Z	_	_	_	_	Υ
85	54	PTE2	ND	Hi-Z	_	_	_	_	Υ
86		VSS	_	_	_	_	_	_	_
87		VDD	_	_	_	_	_	_	_
88		PTA14	ND	Hi-Z	_	_	_	_	Υ
89	55	PTA13	ND	Hi-Z	_	_	_	_	Υ
90	56	PTA12	ND	Hi-Z	_	_	_	_	Υ
91	57	PTA11	ND	Hi-Z	_	_	_	_	Υ
92	58	PTA10	ND	Hi-Z	_	_	_	_	Υ
93	59	PTE1	HD	Hi-Z	_	_	_	_	Υ
94	60	PTE0	HD	Hi-Z	_	_	_	_	Υ
95	61	PTC5	ND	Н	PU	_	_	_	Υ

Table continues on the next page...

Pinouts

100 LQFP	64 LQFP	Pin Name	Driver strength	Default status after POR	Pullup/ pulldown setting after POR	Slew rate after POR	Passive pin filter after POR	True Open Drain	Pin interrupt
96	62	PTC4	ND	L	PD	_	_	_	Υ
97	63	PTA5	ND	Н	PU	_	Υ	_	Υ
98	64	PTA4	ND	Н	PU	_	_	_	Υ
99		PTA9	ND	Hi-Z	_	_	_	_	Υ
100		PTA8	ND	Hi-Z	_	_	_	_	Υ

Properties	Abbreviation	Descriptions
Driver strength	ND	Normal drive
	HD	High drive
Default status after POR	Hi-Z	High impendence
	Н	High level
	L	Low level
Pullup/ pulldown setting	PU	Pullup
after POR	PD	Pulldown
Slew rate after POR	FS	Fast slew rate
	SS	Slow slew rate
Passive Pin Filter after	N	Disabled
POR	Y	Enabled
Open drain	N	Disabled
	Y	Enabled
Pin interrupt	Y	Yes

33.2.3 Pinout diagram

The following figure shows the pinout diagram for the devices supported by this document. Many signals may be multiplexed onto a single pin. To determine what signals can be used on which pin, see the previous table of Pin Assignments.

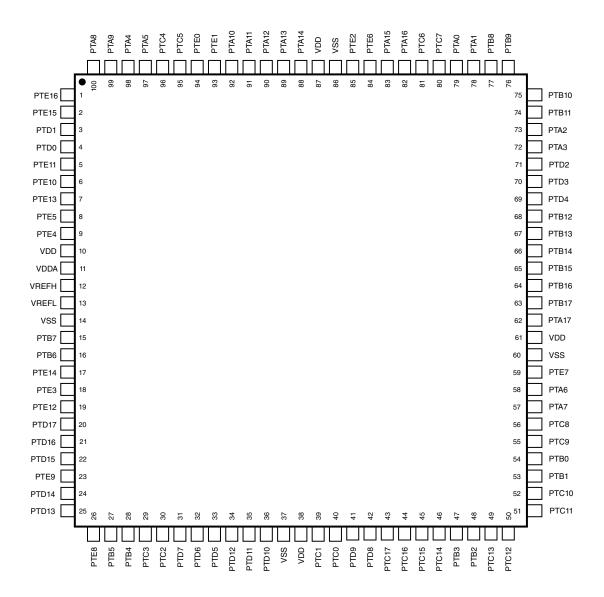


Figure 33-1. 100 LQFP Pinout Diagram

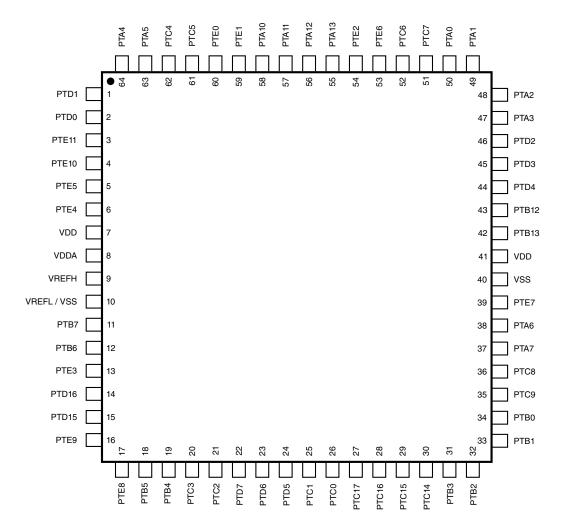


Figure 33-2. 64 LQFP Pinout Diagram

33.3 Module Signal Description Tables

The following sections correlate the chip-level signal name with the signal name used in the module's chapter. They also briefly describe the signal function and direction.

685

33.3.1 Core Modules

Table 33-1. SWD Signal Descriptions

Chip signal name	Module signal name	Description	I/O
SWD_CLK	SWD_CLK	Serial Wire Clock	I
SWD_DIO	SWD_DIO	Serial Wire Data	I/O

33.3.2 System Modules

Table 33-2. System Signal Descriptions

Chip signal name	Module signal name	Description	I/O
NMI_b	_	Non-maskable interrupt NOTE: Driving the NMI signal low forces a non-maskable interrupt, if the NMI function is selected on the corresponding pin.	_
RESET_b	_	Reset bidirectional signal	I/O
VDD	_	MCU power	I
VSS	_	MCU ground	I

Table 33-3. EWM Signal Descriptions

Chip signal name	Module signal name	Description	I/O
EWM_IN	EWM_in	EWM input for safety status of external safety circuits. The polarity of EWM_IN is programmable using the EWM_CTRL[ASSIN] bit. The default polarity is active-low.	I
EWM_OUT_b	EWM_out	EWM reset out signal	0

33.3.3 Clock Modules

Table 33-4. OSC (in SCG) Signal Descriptions

Chip signal name	Module signal name	Description	I/O
EXTAL	EXTAL	External clock/Oscillator input	1
XTAL	XTAL	Oscillator output	0

Module Signal Description Tables

Table 33-5. RTC Oscillator (OSC32) Signal Descriptions

Chip signal name	Module signal name	Description	I/O
EXTAL32	EXTAL32	32.768 kHz oscillator input	I
XTAL32	XTAL32	32.768 kHz oscillator output	0

33.3.4 Analog

Table 33-6. ADC0 Signal Descriptions

Chip signal name	Module signal name	Description	I/O
ADC0_SE[15:0]	AD[15:0]	Single-Ended Analog Channel Inputs	I
VREFH	V_{REFSH}	Voltage Reference Select High	Ţ
VREFL	V_{REFSL}	Voltage Reference Select Low	I
VDDA	V_{DDA}	Analog Power Supply	I

Table 33-7. ADC1 Signal Descriptions

Chip signal name	Module signal name	Description	1/0
ADC1_SE[11:0]	AD[11:0]	Single-Ended Analog Channel Inputs	I
VREFH	V_{REFSH}	Voltage Reference Select High	I
VREFL	V_{REFSL}	Voltage Reference Select Low	I
VDDA	V_{DDA}	Analog Power Supply	I

Table 33-8. ACMP0 Signal Descriptions

Chip signal name	Module signal name	Description	I/O
ACMP0_IN[5:0]	IN[5:0]	Analog voltage inputs	I
ACMP0_OUT	CMPO	Comparator output	0
DAC0_OUT	DAC_OUT	DAC output	0

Table 33-9. ACMP1 Signal Descriptions

Chip signal name	Module signal name	Description	I/O
ACMP1_IN[5:0]	IN[5:0]	Analog voltage inputs	1
ACMP1_OUT	СМРО	Comparator output	0

687

33.3.5 Timer Modules

Table 33-10. LPTMR0 Signal Descriptions

Chip signal name	Module signal name	Description	I/O
LPTMR0_ALT[3:1]	LPTMR_ALT <i>n</i>	Pulse Counter Input pin	I

Table 33-11. RTC Signal Descriptions

Chip signal name	Module signal name	Description	I/O
RTC_CLKOUT	RTC_CLKOUT	Prescaler square-wave output (configurable) or 32kHz crystal clock	0

Table 33-12. FTM0 Signal Descriptions

Chip signal name	Module signal name	Description	I/O
FTM0_CH[7:0]	CHn	FTM channel (n), where n can be 7-0	I/O
FTM0_FLT[3:0]	FAULTj	Fault input (j), where j can be 3-0	I
TCLK[2:0]	EXTCLK	External clock. FTM external clock can be selected to drive the FTM counter.	I

Table 33-13. FTM1 Signal Descriptions

Chip signal name	Module signal name	Description	I/O
FTM1_CH[1:0]	CHn	FTM channel (n), where n can be 1-0	I/O
FTM1_FLT[3:2]	FAULTj	Fault input (j), where j can be 3-2	I
TCLK[2:0]	EXTCLK	External clock. FTM external clock can be selected to drive the FTM counter.	I

Table 33-14. FTM2 Signal Descriptions

Chip signal name	Module signal name	Description	I/O
FTM2_CH[1:0]	CHn	FTM channel (n), where n can be 1-0	I/O
FTM2_FLT[3:2]	FAULTj	Fault input (j), where j can be 3-2	I
TCLK[2:0]	EXTCLK	External clock. FTM external clock can be selected to drive the FTM counter.	I

33.3.6 Communication Interfaces

Table 33-15. LPSPIn Signal Descriptions

Chip signal name	Module signal name	Description	I/O
LPSPIn_SOUT	SOUT	Serial Data Out	0
LPSPIn_SIN	SIN	Serial Data In	I
LPSPIn_SCK	SCK	Serial Clock	I/O
LPSPIn_PCS[3:0]	PCS[3:0]	Peripheral Chip Select 0-3	I/O

Table 33-16. LPI2Cn Signal Descriptions

Chip signal name	Module signal name	Description	I/O
LPI2Cn_SCL	SCL	Bidirectional serial clock line of the I2C system.	I/O
LPI2Cn_SDA	SDA	Bidirectional serial data line of the I2C system.	I/O
LPI2Cn_HREQ	HREQ	Host request, can initiate an LPI2C master transfer if asserted and the I2C bus is idle.	I
LPI2Cn_SCLS	SCLS	Secondary I2C clock line.	I/O
LPI2Cn_SDAS	SDAS	Secondary I2C data line.	I/O

Table 33-17. LPUARTn Signal Descriptions

Chip signal name	Module signal name	Description	I/O
LPUARTn_TX	LPUART_TX	Transmit data	I/O
LPUART <i>n</i> _RX	LPUART_RX	Receive data	I
LPUARTn_CTS	LPUART_CTS	Clear to send	I
LPUARTn_RTS	LPUART_RTS	Request to send	0

Table 33-18. FlexIO Signal Descriptions

Chip signal name	Module signal name	Description	I/O
FXIO_D[7:0]	FXIO_D[7:0]	Bidirectional FlexIO Shifter and Timer pin inputs/outputs	I/O

33.3.7 Human-Machine Interfaces (HMI)

Table 33-19. GPIO Signal Descriptions

Chip signal name	Module signal name		
PTA[17:0]	PORTA17-PORTA0	General-purpose input/output	I/O
PTB[17:0]	PORTB17-PORTB0	General-purpose input/output	I/O
PTC[17:0]	PORTC17-PORTC0	General-purpose input/output	I/O
PTD[17:0]	PORTD17-PORTD0	General-purpose input/output	I/O
PTE[16:0]	PORTE16-PORTE0	General-purpose input/output	I/O

Table 33-20. TSI0 Signal Descriptions

Chip signal name	Module signal name	Description	I/O
TSI0_CH[24:0]	TSI[24:0]	TSI sensing pins or GPIO pins	I/O

Module Signal Description Tables

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Chapter 34 Port Control and Interrupts (PORT)

34.1 Chip-specific information for this module

34.1.1 I/O pin structure

The following figure shows the structure of normal I/O pin.

See Pin properties for properties on each pin.

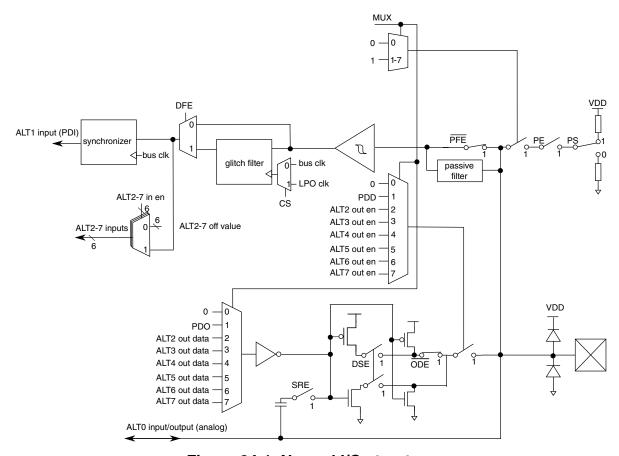


Figure 34-1. Normal I/O structure

34.1.2 Port control and interrupt module features

• 32-pin ports

NOTE

Not all pins are available on the device. See the following section for details.

• Each 32-pin port is assigned one interrupt.

Table 34-1. Ports summary

Feature	Port A	Port B	Port C	Port D	Port E
Pull select control	Yes	Yes	Yes	Yes	Yes
Pull select at reset	PTA4/PTA5=Pull up, Others=No	No	PTC4=Pull down, Others=No	PTD3=Pull up, Others=No	No
Pull enable control	Yes	Yes	Yes	Yes	Yes
Pull enable at reset	PTA4/ PTA5=Enabled; Others=Disabled	Disabled	PTC4=Enabled; Others=Disabled	PTD3=Enabled; Others=Disabled	Disabled
Passive filter enable control	PTA5=Yes; Others=No	No	No	PTD3=Yes; Others=No	No
Passive filter enable at reset	PTA5=Enabled; Others=Disabled	Disabled	Disabled	Disabled	Disabled
Open drain enable control	I2C and UART Tx=Enabled; Others=Disabled				
Open drain enable at reset	Disabled	Disabled	Disabled	Disabled	Disabled
Drive strength enable control	No	PTB4/PTB5 only	No	PTD0/PTD1/ PTD15/PTD16 only	PTE0/PTE1 only
Drive strength enable at reset	Disabled	Disabled	Disabled	Disabled	Disabled
Pin mux control	Yes	Yes	Yes	Yes	Yes
Pin mux at reset	PTA4/PTA5=ALT7; Others=ALT0	ALT0	PTC4=ALT7; Others=ALT0	PTD3=ALT7; Others=ALT0	ALT0
Lock bit	Yes	Yes	Yes	Yes	Yes
Interrupt and DMA request	Yes	Yes	Yes	Yes	Yes
Digital glitch filter	No	No	No	No	Yes

34.1.3 Application-related Information

- 1. A given peripheral function must be assigned to a maximum of one package pin. Do not program the same function to more than one pin.
- 2. To ensure the best signal timing for a given peripheral's interface, choose the pins in closest proximity to each other.
- 3. The clock to the port control module can be gated on and off using the PCC_PORTx register. These bits are cleared after any reset, which disables the clock to the corresponding module to conserve power. Prior to initializing the corresponding module, set PCC_PORTx[CGC] to enable the clock. Before turning off the clock, make sure to disable the module. For more details, refer to the clock distribution chapter.

34.2 Introduction

34.3 Overview

The Port Control and Interrupt (PORT) module provides support for port control, digital filtering, and external interrupt functions.

Most functions can be configured independently for each pin in the 32-bit port and affect the pin regardless of its pin muxing state.

There is one instance of the PORT module for each port. Not all pins within each port are implemented on a specific device.

34.3.1 Features

The PORT module has the following features:

- Pin interrupt
 - Interrupt flag and enable registers for each pin
 - Support for edge sensitive (rising, falling, both) or level sensitive (low, high) configured per pin
 - Support for interrupt or DMA request configured per pin
 - Asynchronous wake-up in low-power modes
 - Pin interrupt is functional in all digital pin muxing modes
- Digital input filter
 - Digital input filter for each pin, usable by any digital peripheral muxed onto the pin
 - Individual enable or bypass control field per pin

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

NXP Semiconductors

693

Overview

- Selectable clock source for digital input filter with a five bit resolution on filter size
- Functional in all digital pin multiplexing modes
- Port control
 - Individual pull control fields with pullup, pulldown, and pull-disable support
 - Individual drive strength field supporting high and low drive strength
 - Individual input passive filter field supporting enable and disable of the individual input passive filter
 - Individual mux control field supporting analog or pin disabled, GPIO, and up to six chip-specific digital functions
 - Pad configuration fields are functional in all digital pin muxing modes.

34.3.2 Modes of operation

34.3.2.1 Run mode

In Run mode, the PORT operates normally.

34.3.2.2 Wait mode

In Wait mode, PORT continues to operate normally and may be configured to exit the Low-Power mode if an enabled interrupt is detected. DMA requests are still generated during the Wait mode, but do not cause an exit from the Low-Power mode.

34.3.2.3 Stop mode

In Stop mode, the PORT can be configured to exit the Low-Power mode via an asynchronous wake-up signal if an enabled interrupt is detected.

In Stop mode, the digital input filters are bypassed unless they are configured to run from the LPO clock source.

34.3.2.4 **Debug mode**

In Debug mode, PORT operates normally.

34.4 External signal description

The table found here describes the PORT external signal.

Table 34-2. Signal properties

Name	Function	I/O	Reset	Pull
PORTx[31:0]	External interrupt	I/O	0	-

NOTE

Not all pins within each port are implemented on each device.

34.5 Detailed signal description

The table found here contains the detailed signal description for the PORT interface.

Table 34-3. PORT interface—detailed signal description

Signal	I/O		Description		
PORTx[31:0]	I/O	External interrupt.	External interrupt.		
		State meaning	Asserted—pin is logic 1.		
			Negated—pin is logic 0.		
		Timing	Assertion—may occur at any time and can assert asynchronously to the system clock.		
			Negation—may occur at any time and can assert asynchronously to the system clock.		

34.6 Memory map and register definition

Any read or write access to the PORT memory space that is outside the valid memory map results in a bus error. All register accesses complete with zero wait states.

PORT memory map

Absolute address (hex)	Register name		Access	Reset value	Section/ page
4004_9000	Pin Control Register n (PORTA_PCR0)	32	R/W	See section	34.6.1/702
4004_9004	Pin Control Register n (PORTA_PCR1)	32	R/W	See section	34.6.1/702
4004_9008	Pin Control Register n (PORTA_PCR2)	32	R/W	See section	34.6.1/702

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Memory map and register definition

PORT memory map (continued)

Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page
4004_900C	Pin Control Register n (PORTA_PCR3)	32	R/W	See section	34.6.1/702
4004_9010	Pin Control Register n (PORTA_PCR4)	32	R/W	See section	34.6.1/702
4004_9014	Pin Control Register n (PORTA_PCR5)	32	R/W	See section	34.6.1/702
4004_9018	Pin Control Register n (PORTA_PCR6)	32	R/W	See section	34.6.1/702
4004_901C	Pin Control Register n (PORTA_PCR7)	32	R/W	See section	34.6.1/702
4004_9020	Pin Control Register n (PORTA_PCR8)	32	R/W	See section	34.6.1/702
4004_9024	Pin Control Register n (PORTA_PCR9)	32	R/W	See section	34.6.1/702
4004_9028	Pin Control Register n (PORTA_PCR10)	32	R/W	See section	34.6.1/702
4004_902C	Pin Control Register n (PORTA_PCR11)	32	R/W	See section	34.6.1/702
4004_9030	Pin Control Register n (PORTA_PCR12)	32	R/W	See section	34.6.1/702
4004_9034	Pin Control Register n (PORTA_PCR13)	32	R/W	See section	34.6.1/702
4004_9038	Pin Control Register n (PORTA_PCR14)	32	R/W	See section	34.6.1/702
4004_903C	Pin Control Register n (PORTA_PCR15)	32	R/W	See section	34.6.1/702
4004_9040	Pin Control Register n (PORTA_PCR16)	32	R/W	See section	34.6.1/702
4004_9044	Pin Control Register n (PORTA_PCR17)	32	R/W	See section	34.6.1/702
4004_9048	Pin Control Register n (PORTA_PCR18)	32	R/W	See section	34.6.1/702
4004_904C	Pin Control Register n (PORTA_PCR19)	32	R/W	See section	34.6.1/702
4004_9050	Pin Control Register n (PORTA_PCR20)	32	R/W	See section	34.6.1/702
4004_9054	Pin Control Register n (PORTA_PCR21)	32	R/W	See section	34.6.1/702
4004_9058	Pin Control Register n (PORTA_PCR22)	32	R/W	See section	34.6.1/702
4004_905C	Pin Control Register n (PORTA_PCR23)	32	R/W	See section	34.6.1/702
4004_9060	Pin Control Register n (PORTA_PCR24)	32	R/W	See section	34.6.1/702
4004_9064	Pin Control Register n (PORTA_PCR25)	32	R/W	See section	34.6.1/702
4004_9068	Pin Control Register n (PORTA_PCR26)	32	R/W	See section	34.6.1/702
4004_906C	Pin Control Register n (PORTA_PCR27)	32	R/W	See section	34.6.1/702
4004_9070	Pin Control Register n (PORTA_PCR28)	32	R/W	See section	34.6.1/702
4004_9074	Pin Control Register n (PORTA_PCR29)	32	R/W	See section	34.6.1/702
4004_9078	Pin Control Register n (PORTA_PCR30)	32	R/W	See section	34.6.1/702
4004_907C	Pin Control Register n (PORTA_PCR31)	32	R/W	See section	34.6.1/702
4004_9080	Global Pin Control Low Register (PORTA_GPCLR)	32	W (always reads 0)	0000_0000h	34.6.2/705
4004_9084	Global Pin Control High Register (PORTA_GPCHR)	32	W (always reads 0)	0000_0000h	34.6.3/705
4004_90A0	Interrupt Status Flag Register (PORTA_ISFR)	32	w1c	0000_0000h	34.6.4/706
4004_90C0	Digital Filter Enable Register (PORTA_DFER)	32	R/W	0000_0000h	34.6.5/706
4004_90C4	Digital Filter Clock Register (PORTA_DFCR)	32	R/W	0000_0000h	34.6.6/707
4004_90C8	Digital Filter Width Register (PORTA_DFWR)	32	R/W	0000_0000h	34.6.7/707

PORT memory map (continued)

Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page
4004_A000	Pin Control Register n (PORTB_PCR0)	32	R/W	See section	34.6.1/702
4004_A004	Pin Control Register n (PORTB_PCR1)	32	R/W	See section	34.6.1/702
4004_A008	Pin Control Register n (PORTB_PCR2)	32	R/W	See section	34.6.1/702
4004_A00C	Pin Control Register n (PORTB_PCR3)	32	R/W	See section	34.6.1/702
4004_A010	Pin Control Register n (PORTB_PCR4)	32	R/W	See section	34.6.1/702
4004_A014	Pin Control Register n (PORTB_PCR5)	32	R/W	See section	34.6.1/702
4004_A018	Pin Control Register n (PORTB_PCR6)	32	R/W	See section	34.6.1/702
4004_A01C	Pin Control Register n (PORTB_PCR7)	32	R/W	See section	34.6.1/702
4004_A020	Pin Control Register n (PORTB_PCR8)	32	R/W	See section	34.6.1/702
4004_A024	Pin Control Register n (PORTB_PCR9)	32	R/W	See section	34.6.1/702
4004_A028	Pin Control Register n (PORTB_PCR10)	32	R/W	See section	34.6.1/702
4004_A02C	Pin Control Register n (PORTB_PCR11)	32	R/W	See section	34.6.1/702
4004_A030	Pin Control Register n (PORTB_PCR12)	32	R/W	See section	34.6.1/702
4004_A034	Pin Control Register n (PORTB_PCR13)	32	R/W	See section	34.6.1/702
4004_A038	Pin Control Register n (PORTB_PCR14)	32	R/W	See section	34.6.1/702
4004_A03C	Pin Control Register n (PORTB_PCR15)	32	R/W	See section	34.6.1/702
4004_A040	Pin Control Register n (PORTB_PCR16)	32	R/W	See section	34.6.1/702
4004_A044	Pin Control Register n (PORTB_PCR17)	32	R/W	See section	34.6.1/702
4004_A048	Pin Control Register n (PORTB_PCR18)	32	R/W	See section	34.6.1/702
4004_A04C	Pin Control Register n (PORTB_PCR19)	32	R/W	See section	34.6.1/702
4004_A050	Pin Control Register n (PORTB_PCR20)	32	R/W	See section	34.6.1/702
4004_A054	Pin Control Register n (PORTB_PCR21)	32	R/W	See section	34.6.1/702
4004_A058	Pin Control Register n (PORTB_PCR22)	32	R/W	See section	34.6.1/702
4004_A05C	Pin Control Register n (PORTB_PCR23)	32	R/W	See section	34.6.1/702
4004_A060	Pin Control Register n (PORTB_PCR24)	32	R/W	See section	34.6.1/702
4004_A064	Pin Control Register n (PORTB_PCR25)	32	R/W	See section	34.6.1/702
4004_A068	Pin Control Register n (PORTB_PCR26)	32	R/W	See section	34.6.1/702
4004_A06C	Pin Control Register n (PORTB_PCR27)	32	R/W	See section	34.6.1/702
4004_A070	Pin Control Register n (PORTB_PCR28)	32	R/W	See section	34.6.1/702
4004_A074	Pin Control Register n (PORTB_PCR29)	32	R/W	See section	34.6.1/702
4004_A078	Pin Control Register n (PORTB_PCR30)	32	R/W	See section	34.6.1/702
4004_A07C	Pin Control Register n (PORTB_PCR31)	32	R/W	See section	34.6.1/702
4004_A080	Global Pin Control Low Register (PORTB_GPCLR)	32	W (always reads 0)	0000_0000h	34.6.2/705
4004_A084	Global Pin Control High Register (PORTB_GPCHR)	32	W (always reads 0)	0000_0000h	34.6.3/705
4004_A0A0	Interrupt Status Flag Register (PORTB_ISFR)	32	w1c	0000_0000h	34.6.4/706

Table continues on the next page...

Memory map and register definition

PORT memory map (continued)

Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page
4004_A0C0	Digital Filter Enable Register (PORTB_DFER)	32	R/W	0000_0000h	34.6.5/706
4004_A0C4	Digital Filter Clock Register (PORTB_DFCR)	32	R/W	0000_0000h	34.6.6/707
4004_A0C8	Digital Filter Width Register (PORTB_DFWR)	32	R/W	0000_0000h	34.6.7/707
4004_B000	Pin Control Register n (PORTC_PCR0)	32	R/W	See section	34.6.1/702
4004_B004	Pin Control Register n (PORTC_PCR1)	32	R/W	See section	34.6.1/702
4004_B008	Pin Control Register n (PORTC_PCR2)	32	R/W	See section	34.6.1/702
4004_B00C	Pin Control Register n (PORTC_PCR3)	32	R/W	See section	34.6.1/702
4004_B010	Pin Control Register n (PORTC_PCR4)	32	R/W	See section	34.6.1/702
4004_B014	Pin Control Register n (PORTC_PCR5)	32	R/W	See section	34.6.1/702
4004_B018	Pin Control Register n (PORTC_PCR6)	32	R/W	See section	34.6.1/702
4004_B01C	Pin Control Register n (PORTC_PCR7)	32	R/W	See section	34.6.1/702
4004_B020	Pin Control Register n (PORTC_PCR8)	32	R/W	See section	34.6.1/702
4004_B024	Pin Control Register n (PORTC_PCR9)	32	R/W	See section	34.6.1/702
4004_B028	Pin Control Register n (PORTC_PCR10)	32	R/W	See section	34.6.1/702
4004_B02C	Pin Control Register n (PORTC_PCR11)	32	R/W	See section	34.6.1/702
4004_B030	Pin Control Register n (PORTC_PCR12)	32	R/W	See section	34.6.1/702
4004_B034	Pin Control Register n (PORTC_PCR13)	32	R/W	See section	34.6.1/702
4004_B038	Pin Control Register n (PORTC_PCR14)	32	R/W	See section	34.6.1/702
4004_B03C	Pin Control Register n (PORTC_PCR15)	32	R/W	See section	34.6.1/702
4004_B040	Pin Control Register n (PORTC_PCR16)	32	R/W	See section	34.6.1/702
4004_B044	Pin Control Register n (PORTC_PCR17)	32	R/W	See section	34.6.1/702
4004_B048	Pin Control Register n (PORTC_PCR18)	32	R/W	See section	34.6.1/702
4004_B04C	Pin Control Register n (PORTC_PCR19)	32	R/W	See section	34.6.1/702
4004_B050	Pin Control Register n (PORTC_PCR20)	32	R/W	See section	34.6.1/702
4004_B054	Pin Control Register n (PORTC_PCR21)	32	R/W	See section	34.6.1/702
4004_B058	Pin Control Register n (PORTC_PCR22)	32	R/W	See section	34.6.1/702
4004_B05C	Pin Control Register n (PORTC_PCR23)	32	R/W	See section	34.6.1/702
4004_B060	Pin Control Register n (PORTC_PCR24)	32	R/W	See section	34.6.1/702
4004_B064	Pin Control Register n (PORTC_PCR25)	32	R/W	See section	34.6.1/702
4004_B068	Pin Control Register n (PORTC_PCR26)	32	R/W	See section	34.6.1/702
4004_B06C	Pin Control Register n (PORTC_PCR27)	32	R/W	See section	34.6.1/702
4004_B070	Pin Control Register n (PORTC_PCR28)	32	R/W	See section	34.6.1/702
4004_B074	Pin Control Register n (PORTC_PCR29)	32	R/W	See section	34.6.1/702
4004_B078	Pin Control Register n (PORTC_PCR30)	32	R/W	See section	34.6.1/702
4004_B07C	Pin Control Register n (PORTC_PCR31)	32	R/W	See section	34.6.1/702
4004_B080	Global Pin Control Low Register (PORTC_GPCLR)	32	W (always reads 0)	0000_0000h	34.6.2/705

Table continues on the next page...

PORT memory map (continued)

Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page
4004_B084	Global Pin Control High Register (PORTC_GPCHR)	32	W (always reads 0)	0000_0000h	34.6.3/705
4004_B0A0	Interrupt Status Flag Register (PORTC_ISFR)	32	w1c	0000_0000h	34.6.4/706
4004_B0C0	Digital Filter Enable Register (PORTC_DFER)	32	R/W	0000_0000h	34.6.5/706
4004_B0C4	Digital Filter Clock Register (PORTC_DFCR)	32	R/W	0000_0000h	34.6.6/707
4004_B0C8	Digital Filter Width Register (PORTC_DFWR)	32	R/W	0000_0000h	34.6.7/707
4004_C000	Pin Control Register n (PORTD_PCR0)	32	R/W	See section	34.6.1/702
4004_C004	Pin Control Register n (PORTD_PCR1)	32	R/W	See section	34.6.1/702
4004_C008	Pin Control Register n (PORTD_PCR2)	32	R/W	See section	34.6.1/702
4004_C00C	Pin Control Register n (PORTD_PCR3)	32	R/W	See section	34.6.1/702
4004_C010	Pin Control Register n (PORTD_PCR4)	32	R/W	See section	34.6.1/702
4004_C014	Pin Control Register n (PORTD_PCR5)	32	R/W	See section	34.6.1/702
4004_C018	Pin Control Register n (PORTD_PCR6)	32	R/W	See section	34.6.1/702
4004_C01C	Pin Control Register n (PORTD_PCR7)	32	R/W	See section	34.6.1/702
4004_C020	Pin Control Register n (PORTD_PCR8)	32	R/W	See section	34.6.1/702
4004_C024	Pin Control Register n (PORTD_PCR9)	32	R/W	See section	34.6.1/702
4004_C028	Pin Control Register n (PORTD_PCR10)	32	R/W	See section	34.6.1/702
4004_C02C	Pin Control Register n (PORTD_PCR11)	32	R/W	See section	34.6.1/702
4004_C030	Pin Control Register n (PORTD_PCR12)	32	R/W	See section	34.6.1/702
4004_C034	Pin Control Register n (PORTD_PCR13)	32	R/W	See section	34.6.1/702
4004_C038	Pin Control Register n (PORTD_PCR14)	32	R/W	See section	34.6.1/702
4004_C03C	Pin Control Register n (PORTD_PCR15)	32	R/W	See section	34.6.1/702
4004_C040	Pin Control Register n (PORTD_PCR16)	32	R/W	See section	34.6.1/702
4004_C044	Pin Control Register n (PORTD_PCR17)	32	R/W	See section	34.6.1/702
4004_C048	Pin Control Register n (PORTD_PCR18)	32	R/W	See section	34.6.1/702
4004_C04C	Pin Control Register n (PORTD_PCR19)	32	R/W	See section	34.6.1/702
4004_C050	Pin Control Register n (PORTD_PCR20)	32	R/W	See section	34.6.1/702
4004_C054	Pin Control Register n (PORTD_PCR21)	32	R/W	See section	34.6.1/702
4004_C058	Pin Control Register n (PORTD_PCR22)	32	R/W	See section	34.6.1/702
4004_C05C	Pin Control Register n (PORTD_PCR23)	32	R/W	See section	34.6.1/702
4004_C060	Pin Control Register n (PORTD_PCR24)	32	R/W	See section	34.6.1/702
4004_C064	Pin Control Register n (PORTD_PCR25)	32	R/W	See section	34.6.1/702
4004_C068	Pin Control Register n (PORTD_PCR26)	32	R/W	See section	34.6.1/702
4004_C06C	Pin Control Register n (PORTD_PCR27)	32	R/W	See section	34.6.1/702
4004_C070	Pin Control Register n (PORTD_PCR28)	32	R/W	See section	34.6.1/702
4004_C074	Pin Control Register n (PORTD_PCR29)	32	R/W	See section	34.6.1/702
4004_C078	Pin Control Register n (PORTD_PCR30)	32	R/W	See section	34.6.1/702

Table continues on the next page...

Memory map and register definition

PORT memory map (continued)

Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page
4004_C07C	Pin Control Register n (PORTD_PCR31)	32	R/W	See section	34.6.1/702
4004_C080	Global Pin Control Low Register (PORTD_GPCLR)	32	W (always reads 0)	0000_0000h	34.6.2/705
4004_C084	Global Pin Control High Register (PORTD_GPCHR)	32	W (always reads 0)	0000_0000h	34.6.3/705
4004_C0A0	Interrupt Status Flag Register (PORTD_ISFR)	32	w1c	0000_0000h	34.6.4/706
4004_C0C0	Digital Filter Enable Register (PORTD_DFER)	32	R/W	0000_0000h	34.6.5/706
4004_C0C4	Digital Filter Clock Register (PORTD_DFCR)	32	R/W	0000_0000h	34.6.6/707
4004_C0C8	Digital Filter Width Register (PORTD_DFWR)	32	R/W	0000_0000h	34.6.7/707
4004_D000	Pin Control Register n (PORTE_PCR0)	32	R/W	See section	34.6.1/702
4004_D004	Pin Control Register n (PORTE_PCR1)	32	R/W	See section	34.6.1/702
4004_D008	Pin Control Register n (PORTE_PCR2)	32	R/W	See section	34.6.1/702
4004_D00C	Pin Control Register n (PORTE_PCR3)	32	R/W	See section	34.6.1/702
4004_D010	Pin Control Register n (PORTE_PCR4)	32	R/W	See section	34.6.1/702
4004_D014	Pin Control Register n (PORTE_PCR5)	32	R/W	See section	34.6.1/702
4004_D018	Pin Control Register n (PORTE_PCR6)	32	R/W	See section	34.6.1/702
4004_D01C	Pin Control Register n (PORTE_PCR7)	32	R/W	See section	34.6.1/702
4004_D020	Pin Control Register n (PORTE_PCR8)	32	R/W	See section	34.6.1/702
4004_D024	Pin Control Register n (PORTE_PCR9)	32	R/W	See section	34.6.1/702
4004_D028	Pin Control Register n (PORTE_PCR10)	32	R/W	See section	34.6.1/702
4004_D02C	Pin Control Register n (PORTE_PCR11)	32	R/W	See section	34.6.1/702
4004_D030	Pin Control Register n (PORTE_PCR12)	32	R/W	See section	34.6.1/702
4004_D034	Pin Control Register n (PORTE_PCR13)	32	R/W	See section	34.6.1/702
4004_D038	Pin Control Register n (PORTE_PCR14)	32	R/W	See section	34.6.1/702
4004_D03C	Pin Control Register n (PORTE_PCR15)	32	R/W	See section	34.6.1/702
4004_D040	Pin Control Register n (PORTE_PCR16)	32	R/W	See section	34.6.1/702
4004_D044	Pin Control Register n (PORTE_PCR17)	32	R/W	See section	34.6.1/702
4004_D048	Pin Control Register n (PORTE_PCR18)	32	R/W	See section	34.6.1/702
4004_D04C	Pin Control Register n (PORTE_PCR19)	32	R/W	See section	34.6.1/702
4004_D050	Pin Control Register n (PORTE_PCR20)	32	R/W	See section	34.6.1/702
4004_D054	Pin Control Register n (PORTE_PCR21)	32	R/W	See section	34.6.1/702
4004_D058	Pin Control Register n (PORTE_PCR22)	32	R/W	See section	34.6.1/702
4004_D05C	Pin Control Register n (PORTE_PCR23)	32	R/W	See section	34.6.1/702
4004_D060	Pin Control Register n (PORTE_PCR24)	32	R/W	See section	34.6.1/702
4004_D064	Pin Control Register n (PORTE_PCR25)	32	R/W	See section	34.6.1/702
4004_D068	Pin Control Register n (PORTE_PCR26)	32	R/W	See section	34.6.1/702
4004_D06C	Pin Control Register n (PORTE_PCR27)	32	R/W	See section	34.6.1/702

Table continues on the next page...

Chapter 34 Port Control and Interrupts (PORT)

PORT memory map (continued)

Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page
4004_D070	Pin Control Register n (PORTE_PCR28)	32	R/W	See section	34.6.1/702
4004_D074	Pin Control Register n (PORTE_PCR29)	32	R/W	See section	34.6.1/702
4004_D078	Pin Control Register n (PORTE_PCR30)	32	R/W	See section	34.6.1/702
4004_D07C	Pin Control Register n (PORTE_PCR31)	32	R/W	See section	34.6.1/702
4004_D080	Global Pin Control Low Register (PORTE_GPCLR)	32	W (always reads 0)	0000_0000h	34.6.2/705
4004_D084	Global Pin Control High Register (PORTE_GPCHR)	32	W (always reads 0)	0000_0000h	34.6.3/705
4004_D0A0	Interrupt Status Flag Register (PORTE_ISFR)	32	w1c	0000_0000h	34.6.4/706
4004_D0C0	Digital Filter Enable Register (PORTE_DFER)	32	R/W	0000_0000h	34.6.5/706
4004_D0C4	Digital Filter Clock Register (PORTE_DFCR)	32	R/W	0000_0000h	34.6.6/707
4004_D0C8	Digital Filter Width Register (PORTE_DFWR)	32	R/W	0000_0000h	34.6.7/707

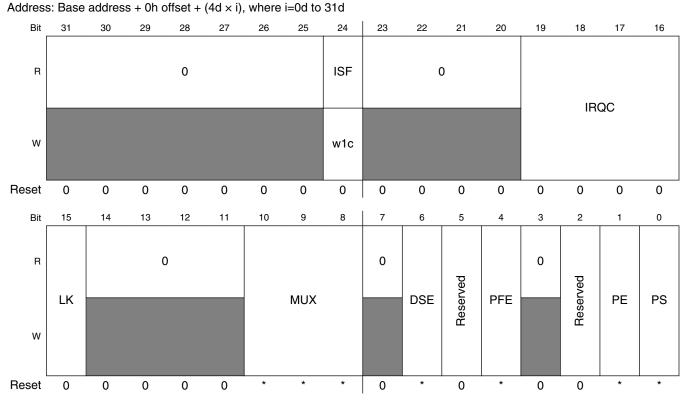
34.6.1 Pin Control Register n (PORTx_PCRn)

NOTE

See the Signal Multiplexing and Pin Assignment chapter for the reset value of this device.

See the GPIO Configuration section for details on the available functions for each pin.

Do not modify pin configuration registers associated with pins that are not available in a reduced-pin package offering. Unbonded pins not available in a package are disabled by default to prevent them from consuming power.



- * Notes
- · MUX field: Varies by port. See Signal Multiplexing and Signal Descriptions chapter for reset values per port.
- · DSE field: Varies by port. See the Signal Multiplexing and Signal Descriptions chapter for reset values per port.
- PFE field: Varies by port. See Signal Multiplexing and Signal Descriptions chapter for reset values per port.
- · PE field: Varies by port. See Signal Multiplexing and Signal Descriptions chapter for reset values per port.
- PS field: Varies by port. See Signal Multiplexing and Signal Descriptions chapter for reset values per port.

PORTx_PCRn field descriptions

Field	Description
31–25 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
24	Interrupt Status Flag
ISF	The pin interrupt configuration is valid in all digital pin muxing modes.
	 Configured interrupt is not detected. Configured interrupt is detected. If the pin is configured to generate a DMA request, then the corresponding flag will be cleared automatically at the completion of the requested DMA transfer. Otherwise, the flag remains set until a logic 1 is written to the flag. If the pin is configured for a level sensitive interrupt and the pin remains asserted, then the flag is set again immediately after it is cleared.
23–20 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
19–16	Interrupt Configuration
IRQC	The pin interrupt configuration is valid in all digital pin muxing modes. The corresponding pin is configured to generate interrupt/DMA request as follows:
	0000 Interrupt Status Flag (ISF) is disabled.
	0001 ISF flag and DMA request on rising edge.
	0010 ISF flag and DMA request on falling edge.
	0011 ISF flag and DMA request on either edge. 0100 Reserved.
	0100 Reserved. 0101 Reserved.
	0110 Reserved.
	0111 Reserved.
	1000 ISF flag and Interrupt when logic 0.
	1001 ISF flag and Interrupt on rising-edge.
	1010 ISF flag and Interrupt on falling-edge.
	1011 ISF flag and Interrupt on either edge.
	1100 ISF flag and Interrupt when logic 1.
	1101 Reserved.
	1110 Reserved.
	1111 Reserved.
15 LK	Lock Register
	 Pin Control Register fields [15:0] are not locked. Pin Control Register fields [15:0] are locked and cannot be updated until the next system reset.
14–11	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
10–8 MUX	Pin Mux Control
INIOA	Not all pins support all pin muxing slots. Unimplemented pin muxing slots are reserved and may result in configuring the pin for a different pin muxing slot.
	The corresponding pin is configured in the following pin muxing slot as follows:
	000 Pin disabled (Alternative 0) (analog).
	001 Alternative 1 (GPIO).
	010 Alternative 2 (chip-specific).

Table continues on the next page...

Memory map and register definition

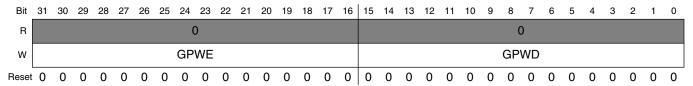
PORTx_PCRn field descriptions (continued)

Field	Description
	011 Alternative 3 (chip-specific). 100 Alternative 4 (chip-specific). 101 Alternative 5 (chip-specific). 110 Alternative 6 (chip-specific). 111 Alternative 7 (chip-specific).
7 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
6 DSE	Drive Strength Enable Drive strength configuration is valid in all digital pin muxing modes. 1 Low drive strength is configured on the corresponding pin, if pin is configured as a digital output. 1 High drive strength is configured on the corresponding pin, if pin is configured as a digital output.
5 Reserved	This field is reserved.
4 PFE	Passive Filter Enable Passive filter configuration is valid in all digital pin muxing modes. O Passive input filter is disabled on the corresponding pin. Passive input filter is enabled on the corresponding pin, if the pin is configured as a digital input. Refer to the device data sheet for filter characteristics.
3 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
2 Reserved	This field is reserved.
1 PE	Pull Enable Pull configuration is valid in all digital pin muxing modes. O Internal pullup or pulldown resistor is not enabled on the corresponding pin. Internal pullup or pulldown resistor is enabled on the corresponding pin, if the pin is configured as a digital input.
0 PS	Pull Select Pull configuration is valid in all digital pin muxing modes. 0 Internal pulldown resistor is enabled on the corresponding pin, if the corresponding PE field is set.
	1 Internal pullup resistor is enabled on the corresponding pin, if the corresponding PE field is set.

34.6.2 Global Pin Control Low Register (PORTx_GPCLR)

Only 32-bit writes are supported to this register.

Address: Base address + 80h offset



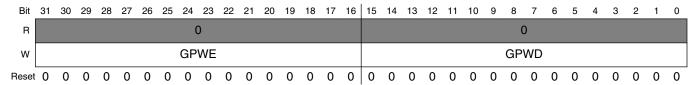
PORTx_GPCLR field descriptions

Field	Description
31–16 GPWE	Global Pin Write Enable
	Selects which Pin Control Registers (15 through 0) bits [15:0] update with the value in GPWD. If a selected Pin Control Register is locked then the write to that register is ignored.
	0 Corresponding Pin Control Register is not updated with the value in GPWD.
	1 Corresponding Pin Control Register is updated with the value in GPWD.
GPWD	Global Pin Write Data
	Write value that is written to all Pin Control Registers bits [15:0] that are selected by GPWE.

34.6.3 Global Pin Control High Register (PORTx_GPCHR)

Only 32-bit writes are supported to this register.

Address: Base address + 84h offset



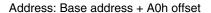
PORTx_GPCHR field descriptions

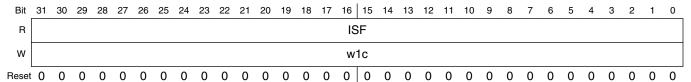
Field	Description
31–16 GPWE	Global Pin Write Enable
J	Selects which Pin Control Registers (31 through 16) bits [15:0] update with the value in GPWD. If a selected Pin Control Register is locked then the write to that register is ignored.
	0 Corresponding Pin Control Register is not updated with the value in GPWD.
	1 Corresponding Pin Control Register is updated with the value in GPWD.
GPWD	Global Pin Write Data
	Write value that is written to all Pin Control Registers bits [15:0] that are selected by GPWE.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

34.6.4 Interrupt Status Flag Register (PORTx_ISFR)

The pin interrupt configuration is valid in all digital pin muxing modes. The Interrupt Status Flag for each pin is also visible in the corresponding Pin Control Register, and each flag can be cleared in either location.





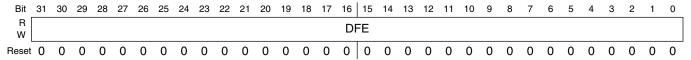
PORTx_ISFR field descriptions

Field	Description			
ISF	Interrupt Status Flag			
	Each bit in the field indicates the detection of the configured interrupt of the same number as the field.			
	O Configured interrupt is not detected.			
	1 Configured interrupt is detected. If the pin is configured to generate a DMA request, then the corresponding flag will be cleared automatically at the completion of the requested DMA transfer. Otherwise, the flag remains set until a logic 1 is written to the flag. If the pin is configured for a level sensitive interrupt and the pin remains asserted, then the flag is set again immediately after it is cleared.			

34.6.5 Digital Filter Enable Register (PORTx_DFER)

The digital filter configuration is valid in all digital pin muxing modes.

Address: Base address + C0h offset



PORTx_DFER field descriptions

Field	Description
DFE	Digital Filter Enable
	The digital filter configuration is valid in all digital pin muxing modes. The output of each digital filter is reset to zero at system reset and whenever the digital filter is disabled. Each bit in the field enables the digital filter of the same number as the field.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

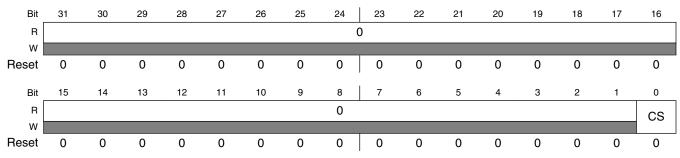
PORTx_DFER field descriptions (continued)

Field	Description
	O Digital filter is disabled on the corresponding pin and output of the digital filter is reset to zero.
	1 Digital filter is enabled on the corresponding pin, if the pin is configured as a digital input.

34.6.6 Digital Filter Clock Register (PORTx_DFCR)

The digital filter configuration is valid in all digital pin muxing modes.





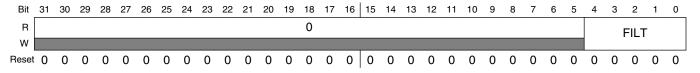
PORTx_DFCR field descriptions

Field	Description
31–1 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
0 CS	Clock Source The digital filter configuration is valid in all digital pin muxing modes. Configures the clock source for the digital input filters. Changing the filter clock source must be done only when all digital filters are disabled. Digital filters are clocked by the bus clock. Digital filters are clocked by the LPO clock.

34.6.7 Digital Filter Width Register (PORTx_DFWR)

The digital filter configuration is valid in all digital pin muxing modes.

Address: Base address + C8h offset



Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

PORTx_DFWR field descriptions

Field	Description
31–5 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
FILT	Filter Length The digital filter configuration is valid in all digital pin muxing modes. Configures the maximum size of the glitches, in clock cycles, that the digital filter absorbs for the enabled digital filters. Glitches that are longer than this register setting will pass through the digital filter, and glitches that are equal to or less than this register setting are filtered. Changing the filter length must be done only after all filters are disabled.

34.7 Functional description

34.7.1 Pin control

Each port pin has a corresponding Pin Control register, PORT_PCRn, associated with it.

The upper half of the Pin Control register configures the pin's capability to either interrupt the CPU or request a DMA transfer, on a rising/falling edge or both edges as well as a logic level occurring on the port pin. It also includes a flag to indicate that an interrupt has occurred.

The lower half of the Pin Control register configures the following functions for each pin within the 32-bit port.

- Pullup or pulldown enable
- Drive strength
- Passive input filter enable
- Pin Muxing mode

The functions apply across all digital pin muxing modes and individual peripherals do not override the configuration in the Pin Control register. For example, if an I²C function is enabled on a pin, that does not override the pullup configuration for that pin.

When the Pin Muxing mode is configured for analog or is disabled, all the digital functions on that pin are disabled. This includes the pullup and pulldown enables, output buffer enable, input buffer enable, and passive filter enable.

The LK bit (bit 15 of Pin Control Register PCRn) allows the configuration for each pin to be locked until the next system reset. When locked, writes to the lower half of that pin control register are ignored, although a bus error is not generated on an attempted write to a locked register.

The configuration of each Pin Control register is retained when the PORT module is disabled.

Whenever a pin is configured in any digital pin muxing mode, the input buffer for that pin is enabled allowing the pin state to be read via the corresponding GPIO Port Data Input Register (GPIO_PDIR) or allowing a pin interrupt or DMA request to be generated. If a pin is ever floating when its input buffer is enabled, then this can cause an increase in power consumption and must be avoided. A pin can be floating due to an input pin that is not connected or an output pin that has tri-stated (output buffer is disabled).

Enabling the internal pull resistor (or implementing an external pull resistor) will ensure a pin does not float when its input buffer is enabled; note that the internal pull resistor is automatically disabled whenever the output buffer is enabled allowing the Pull Enable bit to remain set. Configuring the Pin Muxing mode to disabled or analog will disable the pin's input buffer and results in the lowest power consumption.

34.7.2 Global pin control

The two global pin control registers allow a single register write to update the lower half of the pin control register on up to 16 pins, all with the same value. Registers that are locked cannot be written using the global pin control registers.

The global pin control registers are designed to enable software to quickly configure multiple pins within the one port for the same peripheral function. However, the interrupt functions cannot be configured using the global pin control registers.

The global pin control registers are write-only registers, that always read as 0.

34.7.3 External interrupts

The external interrupt capability of the PORT module is available in all digital pin muxing modes provided the PORT module is enabled.

Each pin can be individually configured for any of the following external interrupt modes:

- Interrupt disabled, default out of reset
- Active high level sensitive interrupt
- Active low level sensitive interrupt
- Rising edge sensitive interrupt
- Falling edge sensitive interrupt
- Rising and falling edge sensitive interrupt

Functional description

- Rising edge sensitive DMA request
- Falling edge sensitive DMA request
- Rising and falling edge sensitive DMA request

The interrupt status flag is set when the configured edge or level is detected on the pin or at the output of the digital input filter, if the digital input digital filter is enabled. When not in Stop mode, the input is first synchronized to the bus clock to detect the configured level or edge transition.

The PORT module generates a single interrupt that asserts when the interrupt status flag is set for any enabled interrupt for that port. The interrupt negates after the interrupt status flags for all enabled interrupts have been cleared by writing a logic 1 to the ISF flag in either the PORT_ISFR or PORT_PCRn registers.

The PORT module generates a single DMA request that asserts when the interrupt status flag is set for any enabled DMA request in that port. The DMA request negates after the DMA transfer is completed, because that clears the interrupt status flags for all enabled DMA requests.

During Stop mode, the interrupt status flag for any enabled interrupt is asynchronously set if the required level or edge is detected. This also generates an asynchronous wake-up signal to exit the Low-Power mode.

34.7.4 Digital filter

The digital filter capabilities of the PORT module are available in all digital Pin Muxing modes if the PORT module is enabled.

The clock used for all digital filters within one port can be configured between the bus clock or the LPO clock. This selection must be changed only when all digital filters for that port are disabled. If the digital filters for a port are configured to use the bus clock, then the digital filters are bypassed for the duration of Stop mode. While the digital filters are bypassed, the output of each digital filter always equals the input pin, but the internal state of the digital filters remains static and does not update due to any change on the input pin.

The filter width in clock size is the same for all enabled digital filters within one port and must be changed only when all digital filters for that port are disabled.

The output of each digital filter is logic zero after system reset and whenever a digital filter is disabled. After a digital filter is enabled, the input is synchronized to the filter clock, either the bus clock or the LPO clock. If the synchronized input and the output of

the digital filter remain different for a number of filter clock cycles equal to the filter width register configuration, then the output of the digital filter updates to equal the synchronized filter input.

The maximum latency through a digital filter equals three filter clock cycles plus the filter width configuration register.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Functional description

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Chapter 35 General-Purpose Input/Output (GPIO)

35.1 Chip-specific information for this module

35.1.1 Instantiation Information

The number of GPIO signals available on the devices covered by this document are detailed in the "Ordering information" of the DataSheet.

See Pin properties for features of each pins.

Port control and interrupt module features are supported, each 32-pin port will support a single interrupt. The pins of PORT_E support digital filter functions.

35.1.2 GPIO accessibility in the memory map

The GPIO is multi-ported and can be accessed directly by the core with zero wait states at base address 0xF800_0000. It can also be accessed by the core and DMA masters through the cross bar/AIPS interface at 0x400F_F000 and at an aliased slot (15) at address 0x4000_F000. All BME operations to the GPIO space can be accomplished referencing the aliased slot (15) at address 0x4000_F000. Only some of the BME operations can be accomplished referencing GPIO at address 0x400F_F000.

35.2 Introduction

The GPIO registers support 8-bit, 16-bit or 32-bit accesses.

Introduction

The GPIO data direction and output data registers control the direction and output data of each pin when the pin is configured for the GPIO function. The GPIO input data register displays the logic value on each pin when the pin is configured for any digital function, provided the corresponding Port Control and Interrupt module for that pin is enabled.

Efficient bit manipulation of the general-purpose outputs is supported through the addition of set, clear, and toggle write-only registers for each port output data register.

35.2.1 Features

Features of the GPIO module include:

- Port Data Input register visible in all digital pin-multiplexing modes
- Port Data Output register with corresponding set/clear/toggle registers
- Port Data Direction register
- Zero wait state access to GPIO registers through IOPORT

NOTE

The GPIO module is clocked by system clock.

35.2.2 Modes of operation

The following table depicts different modes of operation and the behavior of the GPIO module in these modes.

 Modes of operation
 Description

 Run
 The GPIO module operates normally.

 Wait
 The GPIO module operates normally.

 Stop
 The GPIO module is disabled.

 Debug
 The GPIO module operates normally.

Table 35-1. Modes of operation

35.2.3 GPIO signal descriptions

Table 35-2. GPIO signal descriptions

GPIO signal descriptions	Description	I/O
PORTA31-PORTA0	General-purpose input/output	I/O
PORTB31-PORTB0	General-purpose input/output	I/O
PORTC31-PORTC0	General-purpose input/output	I/O
PORTD31-PORTD0	General-purpose input/output	I/O

Table continues on the next page...

Table 35-2. GPIO signal descriptions (continued)

GPIO signal descriptions	Description	I/O
PORTE31-PORTE0	General-purpose input/output	I/O

NOTE

Not all pins within each port are implemented on each device. See the chapter on signal multiplexing for the number of GPIO ports available in the device.

35.2.3.1 Detailed signal description

Table 35-3. GPIO interface-detailed signal descriptions

Signal	I/O	Description		
PORTA31-PORTA0	I/O	General-purpose input/output		
PORTB31-PORTB0		State meaning	Asserted: The pin is logic 1.	
PORTC31-PORTC0			Deasserted: The pin is logic 0.	
PORTD31-PORTD0		Timing	Assertion: When output, this	
PORTE31-PORTE0			signal occurs on the rising- edge of the system clock. For input, it may occur at any time and input may be asserted asynchronously to the system clock.	
			Deassertion: When output, this signal occurs on the rising-edge of the system clock. For input, it may occur at any time and input may be asserted asynchronously to the system clock.	

NOTE

Not all pins within each port are implemented on each device. See the chapter on signal multiplexing for the number of GPIO ports available in the device.

35.3 Memory map and register definition

Any read or write access to the GPIO memory space that is outside the valid memory map results in a bus error.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Memory map and register definition

GPIO memory map

Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page
400F_F000	Port Data Output Register (GPIOA_PDOR)	32	R/W	0000_0000h	35.3.1/717
400F_F004	Port Set Output Register (GPIOA_PSOR)	32	W (always reads 0)	0000_0000h	35.3.2/718
400F_F008	Port Clear Output Register (GPIOA_PCOR)	32	W (always reads 0)	0000_0000h	35.3.3/718
400F_F00C	Port Toggle Output Register (GPIOA_PTOR)	32	W (always reads 0)	0000_0000h	35.3.4/719
400F_F010	Port Data Input Register (GPIOA_PDIR)	32	R	0000_0000h	35.3.5/719
400F_F014	Port Data Direction Register (GPIOA_PDDR)	32	R/W	0000_0000h	35.3.6/720
400F_F040	Port Data Output Register (GPIOB_PDOR)	32	R/W	0000_0000h	35.3.1/717
400F_F044	Port Set Output Register (GPIOB_PSOR)	32	W (always reads 0)	0000_0000h	35.3.2/718
400F_F048	Port Clear Output Register (GPIOB_PCOR)	32	W (always reads 0)	0000_0000h	35.3.3/718
400F_F04C	Port Toggle Output Register (GPIOB_PTOR)	32	W (always reads 0)	0000_0000h	35.3.4/719
400F_F050	Port Data Input Register (GPIOB_PDIR)	32	R	0000_0000h	35.3.5/719
400F_F054	Port Data Direction Register (GPIOB_PDDR)	32	R/W	0000_0000h	35.3.6/720
400F_F080	Port Data Output Register (GPIOC_PDOR)	32	R/W	0000_0000h	35.3.1/717
400F_F084	Port Set Output Register (GPIOC_PSOR)	32	W (always reads 0)	0000_0000h	35.3.2/718
400F_F088	Port Clear Output Register (GPIOC_PCOR)	32	W (always reads 0)	0000_0000h	35.3.3/718
400F_F08C	Port Toggle Output Register (GPIOC_PTOR)	32	W (always reads 0)	0000_0000h	35.3.4/719
400F_F090	Port Data Input Register (GPIOC_PDIR)	32	R	0000_0000h	35.3.5/719
400F_F094	Port Data Direction Register (GPIOC_PDDR)	32	R/W	0000_0000h	35.3.6/720
400F_F0C0	Port Data Output Register (GPIOD_PDOR)	32	R/W	0000_0000h	35.3.1/717
400F_F0C4	Port Set Output Register (GPIOD_PSOR)	32	W (always reads 0)	0000_0000h	35.3.2/718
400F_F0C8	Port Clear Output Register (GPIOD_PCOR)	32	W (always reads 0)	0000_0000h	35.3.3/718

Table continues on the next page...

GPIO memory map (continued)

Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page
400F_F0CC	Port Toggle Output Register (GPIOD_PTOR)	32	W (always reads 0)	0000_0000h	35.3.4/719
400F_F0D0	Port Data Input Register (GPIOD_PDIR)	32	R	0000_0000h	35.3.5/719
400F_F0D4	Port Data Direction Register (GPIOD_PDDR)	32	R/W	0000_0000h	35.3.6/720
400F_F100	Port Data Output Register (GPIOE_PDOR)	32	R/W	0000_0000h	35.3.1/717
400F_F104	Port Set Output Register (GPIOE_PSOR)	32	W (always reads 0)	0000_0000h	35.3.2/718
400F_F108	Port Clear Output Register (GPIOE_PCOR)	32	W (always reads 0)	0000_0000h	35.3.3/718
400F_F10C	Port Toggle Output Register (GPIOE_PTOR)	32	W (always reads 0)	0000_0000h	35.3.4/719
400F_F110	Port Data Input Register (GPIOE_PDIR)	32	R	0000_0000h	35.3.5/719
400F_F114	Port Data Direction Register (GPIOE_PDDR)	32	R/W	0000_0000h	35.3.6/720

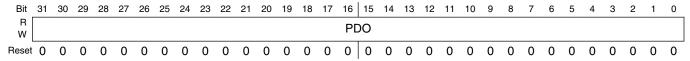
35.3.1 Port Data Output Register (GPIOx_PDOR)

This register configures the logic levels that are driven on each general-purpose output pins.

NOTE

Do not modify pin configuration registers associated with pins not available in your selected package. All unbonded pins not available in your package will default to DISABLE state for lowest power consumption.

Address: Base address + 0h offset



GPIOx_PDOR field descriptions

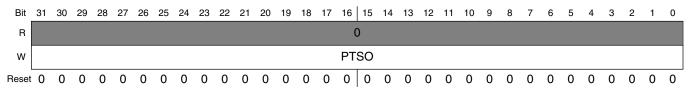
Field	Description
PDO	Port Data Output
	Register bits for unbonded pins return a undefined value when read.
	 Logic level 0 is driven on pin, provided pin is configured for general-purpose output. Logic level 1 is driven on pin, provided pin is configured for general-purpose output.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

35.3.2 Port Set Output Register (GPIOx_PSOR)

This register configures whether to set the fields of the PDOR.

Address: Base address + 4h offset



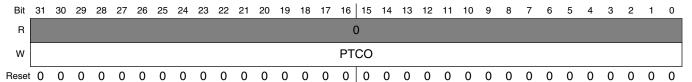
GPIOx_PSOR field descriptions

Field	Description
PTSO	Port Set Output
	Writing to this register will update the contents of the corresponding bit in the PDOR as follows:
	0 Corresponding bit in PDORn does not change.
	1 Corresponding bit in PDORn is set to logic 1.

35.3.3 Port Clear Output Register (GPIOx_PCOR)

This register configures whether to clear the fields of PDOR.

Address: Base address + 8h offset

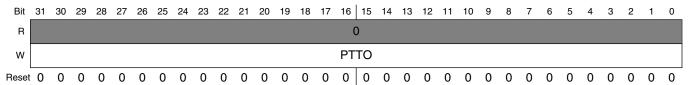


GPIOx_PCOR field descriptions

Field	Description
PTCO	Port Clear Output
	Writing to this register will update the contents of the corresponding bit in the Port Data Output Register (PDOR) as follows:
	0 Corresponding bit in PDORn does not change.
	1 Corresponding bit in PDORn is cleared to logic 0.

35.3.4 Port Toggle Output Register (GPIOx_PTOR)

Address: Base address + Ch offset



GPIOx_PTOR field descriptions

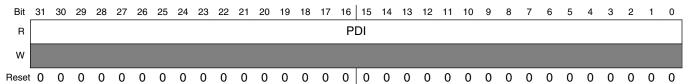
Field	Description
PTTO	Port Toggle Output
	Writing to this register will update the contents of the corresponding bit in the PDOR as follows:
	0 Corresponding bit in PDORn does not change.
	1 Corresponding bit in PDORn is set to the inverse of its existing logic state.

35.3.5 Port Data Input Register (GPIOx_PDIR)

NOTE

Do not modify pin configuration registers associated with pins not available in your selected package. All unbonded pins not available in your package will default to DISABLE state for lowest power consumption.

Address: Base address + 10h offset



GPIOx_PDIR field descriptions

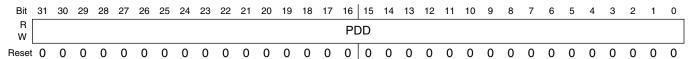
Field	Description				
PDI	Port Data Input				
	Reads 0 at the unimplemented pins for a particular device. Pins that are not configured for a digital function read 0. If the Port Control and Interrupt module is disabled, then the corresponding bit in PDIR does not update.				
	 0 Pin logic level is logic 0, or is not configured for use by digital function. 1 Pin logic level is logic 1. 				

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Port Data Direction Register (GPIOx PDDR) 35.3.6

The PDDR configures the individual port pins for input or output.

Address: Base address + 14h offset



GPIOx_PDDR field descriptions

Field	Description				
PDD	Port Data Direction				
	Configures individual port pins for input or output.				
	0 Pin is configured as general-purpose input, for the GPIO function.				
	1 Pin is configured as general-purpose output, for the GPIO function.				

35.4 FGPIO memory map and register definition

The GPIO registers are also aliased to the IOPORT interface on the Cortex-M0+ from address 0xF800_0000.

Accesses via the IOPORT interface occur in parallel with any instruction fetches and will therefore complete in a single cycle. This aliased Fast GPIO memory map is called FGPIO.

Any read or write access to the FGPIO memory space that is outside the valid memory map results in a bus error. All register accesses complete with zero wait states, except error accesses which complete with one wait state.

FGPIO memory map

Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page
F800_0000	Port Data Output Register (FGPIOA_PDOR)	32	R/W	0000_0000h	35.4.1/722
F800_0004	Port Set Output Register (FGPIOA_PSOR)	32	W (always reads 0)	0000_0000h	35.4.2/722
F800_0008	Port Clear Output Register (FGPIOA_PCOR)	32	W (always reads 0)	0000_0000h	35.4.3/723

Table continues on the next page...

FGPIO memory map (continued)

Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page
F800_000C	Port Toggle Output Register (FGPIOA_PTOR)	32	W (always reads 0)	0000_0000h	35.4.4/723
F800_0010	Port Data Input Register (FGPIOA_PDIR)	32	R	0000_0000h	35.4.5/724
F800_0014	Port Data Direction Register (FGPIOA_PDDR)	32	R/W	0000_0000h	35.4.6/724
F800_0040	Port Data Output Register (FGPIOB_PDOR)	32	R/W	0000_0000h	35.4.1/722
F800_0044	Port Set Output Register (FGPIOB_PSOR)	32	W (always reads 0)	0000_0000h	35.4.2/722
F800_0048	Port Clear Output Register (FGPIOB_PCOR)	32	W (always reads 0)	0000_0000h	35.4.3/723
F800_004C	Port Toggle Output Register (FGPIOB_PTOR)	32	W (always reads 0)	0000_0000h	35.4.4/723
F800_0050	Port Data Input Register (FGPIOB_PDIR)	32	R	0000_0000h	35.4.5/724
F800_0054	Port Data Direction Register (FGPIOB_PDDR)	32	R/W	0000_0000h	35.4.6/724
F800_0080	Port Data Output Register (FGPIOC_PDOR)	32	R/W	0000_0000h	35.4.1/722
F800_0084	Port Set Output Register (FGPIOC_PSOR)	32	W (always reads 0)	0000_0000h	35.4.2/722
F800_0088	Port Clear Output Register (FGPIOC_PCOR)	32	W (always reads 0)	0000_0000h	35.4.3/723
F800_008C	Port Toggle Output Register (FGPIOC_PTOR)	32	W (always reads 0)	0000_0000h	35.4.4/723
F800_0090	Port Data Input Register (FGPIOC_PDIR)	32	R	0000_0000h	35.4.5/724
F800_0094	Port Data Direction Register (FGPIOC_PDDR)	32	R/W	0000_0000h	35.4.6/724
F800_00C0	Port Data Output Register (FGPIOD_PDOR)	32	R/W	0000_0000h	35.4.1/722
F800_00C4	Port Set Output Register (FGPIOD_PSOR)	32	W (always reads 0)	0000_0000h	35.4.2/722
F800_00C8	Port Clear Output Register (FGPIOD_PCOR)	32	W (always reads 0)	0000_0000h	35.4.3/723
F800_00CC	Port Toggle Output Register (FGPIOD_PTOR)	32	W (always reads 0)	0000_0000h	35.4.4/723
F800_00D0	Port Data Input Register (FGPIOD_PDIR)	32	R	0000_0000h	35.4.5/724
F800_00D4	Port Data Direction Register (FGPIOD_PDDR)	32	R/W	0000_0000h	35.4.6/724
F800_0100	Port Data Output Register (FGPIOE_PDOR)	32	R/W	0000_0000h	35.4.1/722

Table continues on the next page...

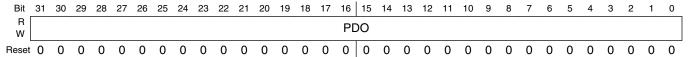
FGPIO memory map (continued)

Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page
F800_0104	Port Set Output Register (FGPIOE_PSOR)	32	W (always reads 0)	0000_0000h	35.4.2/722
F800_0108	Port Clear Output Register (FGPIOE_PCOR)	32	W (always reads 0)	0000_0000h	35.4.3/723
F800_010C	Port Toggle Output Register (FGPIOE_PTOR)	32	W (always reads 0)	0000_0000h	35.4.4/723
F800_0110	Port Data Input Register (FGPIOE_PDIR)	32	R	0000_0000h	35.4.5/724
F800_0114	Port Data Direction Register (FGPIOE_PDDR)	32	R/W	0000_0000h	35.4.6/724

35.4.1 Port Data Output Register (FGPIOx_PDOR)

This register configures the logic levels that are driven on each general-purpose output pins.

Address: Base address + 0h offset



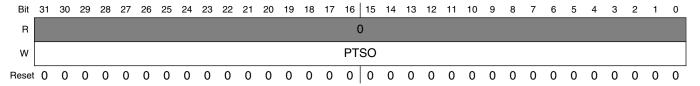
FGPIOx_PDOR field descriptions

Field	Description	
PDO	Port Data Output	
	Unimplemented pins for a particular device read as zero.	
	 Logic level 0 is driven on pin, provided pin is configured for general-purpose output. Logic level 1 is driven on pin, provided pin is configured for general-purpose output. 	

35.4.2 Port Set Output Register (FGPIOx_PSOR)

This register configures whether to set the fields of the PDOR.

Address: Base address + 4h offset



Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

723

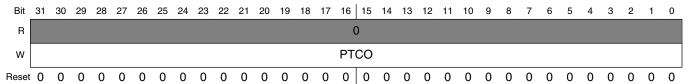
FGPIOx_PSOR field descriptions

Field	Description	
PTSO	Port Set Output	
	Writing to this register will update the contents of the corresponding bit in the PDOR as follows:	
	0 Corresponding bit in PDORn does not change.	
	1 Corresponding bit in PDORn is set to logic 1.	

35.4.3 Port Clear Output Register (FGPIOx_PCOR)

This register configures whether to clear the fields of PDOR.

Address: Base address + 8h offset

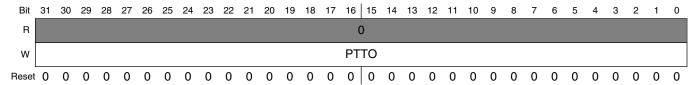


FGPIOx_PCOR field descriptions

Field	Description
PTCO	Port Clear Output
	Writing to this register will update the contents of the corresponding bit in the Port Data Output Register (PDOR) as follows:
	0 Corresponding bit in PDORn does not change.
	1 Corresponding bit in PDORn is cleared to logic 0.

35.4.4 Port Toggle Output Register (FGPIOx_PTOR)

Address: Base address + Ch offset



FGPIOx_PTOR field descriptions

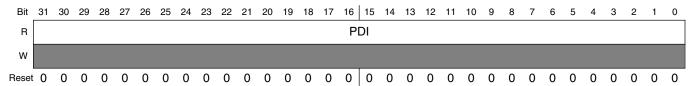
Field	Description
PTTO	Port Toggle Output
	Writing to this register will update the contents of the corresponding bit in the PDOR as follows:

FGPIOx_PTOR field descriptions (continued)

Field	Description	
	0 Corresponding bit in PDORn does not change.	
	1 Corresponding bit in PDORn is set to the inverse of its existing logic state.	

35.4.5 Port Data Input Register (FGPIOx_PDIR)

Address: Base address + 10h offset



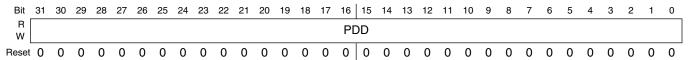
FGPIOx_PDIR field descriptions

Field	Description
PDI	Port Data Input
	Reads 0 at the unimplemented pins for a particular device. Pins that are not configured for a digital function read 0. If the Port Control and Interrupt module is disabled, then the corresponding bit in PDIR does not update.
	0 Pin logic level is logic 0, or is not configured for use by digital function.1 Pin logic level is logic 1.

35.4.6 Port Data Direction Register (FGPIOx_PDDR)

The PDDR configures the individual port pins for input or output.

Address: Base address + 14h offset



FGPIOx_PDDR field descriptions

Field	Description
PDD	Port Data Direction
	Configures individual port pins for input or output.
	0 Pin is configured as general-purpose input, for the GPIO function.
	Pin is configured as general-purpose output, for the GPIO function.

725

35.5 Functional description

35.5.1 General-purpose input

The logic state of each pin is available via the Port Data Input registers, provided the pin is configured for a digital function and the corresponding Port Control and Interrupt module is enabled.

The Port Data Input registers return the synchronized pin state after any enabled digital filter in the Port Control and Interrupt module. The input pin synchronizers are shared with the Port Control and Interrupt module, so that if the corresponding Port Control and Interrupt module is disabled, then synchronizers are also disabled. This reduces power consumption when a port is not required for general-purpose input functionality.

35.5.2 General-purpose output

The logic state of each pin can be controlled via the port data output registers and port data direction registers, provided the pin is configured for the GPIO function. The following table depicts the conditions for a pin to be configured as input/output.

If	Then
A pin is configured for the GPIO function and the corresponding port data direction register bit is clear.	The pin is configured as an input.
A pin is configured for the GPIO function and the corresponding port data direction register bit is set.	The pin is configured as an output and and the logic state of the pin is equal to the corresponding port data output register.

To facilitate efficient bit manipulation on the general-purpose outputs, pin data set, pin data clear, and pin data toggle registers exist to allow one or more outputs within one port to be set, cleared, or toggled from a single register write.

The corresponding Port Control and Interrupt module does not need to be enabled to update the state of the port data direction registers and port data output registers including the set/clear/toggle registers.

Functional description

35.5.3 IOPORT

The GPIO registers are also aliased to the IOPORT interface on the Cortex-M0+ from address 0xF800_0000. Accesses via the IOPORT interface occur in parallel with any instruction fetches and will therefore complete in a single cycle. If the DMA attempts to access the GPIO registers on the same cycle as an IOPORT access, then the DMA access will stall until any IOPORT accesses have completed.

Chapter 36 Analog-to-Digital Converter (ADC)

36.1 Chip-specific information for this module

36.1.1 Instantiation information

Number of ADC	2
Number of result registers per ADC	2

36.1.1.1 Number of ADC channels

Each SAR ADC supports up to 16 external analog input channels, but the exact ADC channel number present on the device is different with packages as indicated in following table.

For details regarding a specific ADC channel available on a particular package, refer to the signal multiplexing chapter of this MCU.

Table 36-1. ADC external channels per package

ADC Module	100LQFP	64LQFP/QFP	80LQFP ¹
ADC0	16	16	16
ADC1	12	11	12

^{1.} This package for the product is not yet available. However, it is included in Package Your Way program for Kinetis MCU. Visit nxp.com/KPYW for more details.

36.1.1.2 ADC Connections/Channel Assignment

Chip-specific information for this module

36.1.1.2.1 ADC0 channel assignment

The ADC0 channel assignments for the device are shown in following table. Reserved channels convert to an unknown value.

Table 36-2. ADC0 channel assignment

ADCH Value	Channel	Input		
00000	AD0	PTA0/ADC0_SE0		
00001	AD1	PTA1/ADC0_SE1		
00010	AD2	PTA6/ADC0_SE2		
00011	AD3	PTA7/ADC0_SE3		
00100	AD4	PTB0/ADC0_SE4		
00101	AD5	PTB1/ADC0_SE5		
00110	AD6	PTB2/ADC0_SE6		
00111	AD7	PTB3/ADC0_SE7		
01000	AD8	PTC0/ADC0_SE8		
01001	AD9	PTC1/ADC0_SE9		
01010	AD10	PTC2/ADC0_SE10		
01011	AD11	PTC3/ADC0_SE11		
01100	AD12	PTC14/ADC0_SE12		
01101	AD13	PTC15/ADC0_SE13		
01110	AD14	PTC16/ADC0_SE14		
01111	AD15	PTC17/ADC0_SE15		
10000	AD16	Reserved		
10001	AD17	Reserved		
10010	AD18	Reserved		
10011	AD19	Reserved		
10100	AD20	Reserved		
10101	AD21	Reserved		
10110	AD22	Reserved		
10111	AD23	CMP1 8-bit DAC out		
11000	AD24	Reserved		
11001	AD25	Reserved		
11010	AD26	Temperature Sensor		
11011	AD27	Bandgap (1V reference voltage)		
11100	AD28	Reserved		
11101	AD29	VREFH		
11110	AD30	VREFL		
11111	Module disabled	None		

36.1.1.2.2 ADC1 channel assignment

The ADC1 channel assignments for the device are shown in following table. Reserved channels convert to an unknown value.

Table 36-3. ADC1 channel assignment

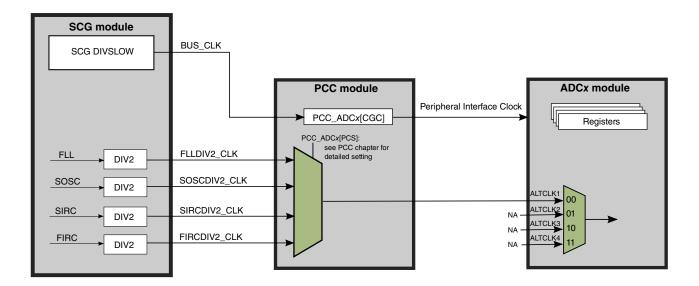
ADCH Value	Channel	Input		
00000	AD0	PTA2/ADC1_SE0		
00001	AD1	PTA3/ADC1_SE1		
00010	AD2	PTD2/ADC1_SE2		
00011	AD3	PTD3/ADC1_SE3		
00100	AD4	PTC6/ADC1_SE4		
00101	AD5	PTC7/ADC1_SE5		
00110	AD6	PTD4/ADC1_SE6		
00111	AD7	PTB12/ADC1_SE7		
01000	AD8	PTB13/ADC1_SE8		
01001	AD9	PTB14/ADC1_SE9		
01010	AD10	PTE2/ADC1_SE10		
01011	AD11	PTE6/ADC1_SE11		
01100	AD12	Reserved		
01101	AD13	Reserved		
01110	AD14	Reserved		
01111	AD15	Reserved		
10000	AD16	Reserved		
10001	AD17	Reserved		
10010	AD18	Reserved		
10011	AD19	Reserved		
10100	AD20	Reserved		
10101	AD21	Reserved		
10110	AD22	Reserved		
10111	AD23	Reserved		
11000	AD24	Reserved		
11001	AD25	Reserved		
11010	AD26	Temperature Sensor		
11011	AD27	Bandgap (1V reference voltage)		
11100	AD28	Reserved		
11101	AD29	VREFH		
11110	AD30	VREFL		
11111	Module disabled	None		

Chip-specific information for this module

36.1.2 ADC Clocking Information

The following figure shows the input clock sources available for this module.

Peripheral Clocking - ADC

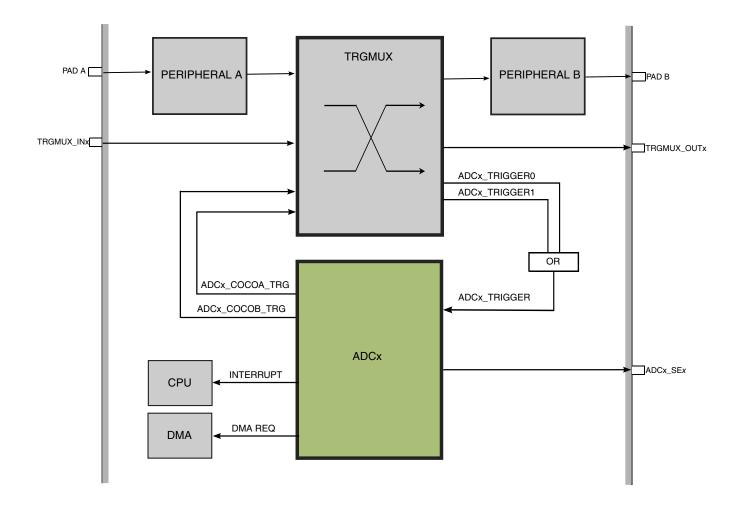


NOTE

ALTCLK2~4 are not connected on this chip.

36.1.3 Inter-connectivity Information

The ADC inter-connectivity is shown in following diagram.



36.1.4 Application-related Information

36.1.4.1 ADC Hardware Interleaved Channels

On this device, there are several special ADC channels which support hardware interleave between multiple ADCs. Taking ADC0_SE4 and ADC1_SE14 channels as an example, these two channels can work independently, but they can also be hardware interleaved as shown in the following diagram. In the hardware interleaved mode, a signal on the pin PTB0 can be sampled by both ADC0 and ADC1. The interleaved mode is enabled by SIM_CHIPCTL[ADC_INTERLEAVE_EN] bits.

The hardware interleave implementation on this device is as follows:

• ADC0_SE4 and ADC1_SE14 channels are interleaved on PTB0 pin

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Chip-specific information for this module

- ADC0_SE5 and ADC1_SE15 channels are interleaved on PTB1 pin
- ADC1_SE8 and ADC0_SEx channels are interleaved on PTB13 pin
- ADC1_SE9 and ADC0_SEx channels are interleaved on PTB14 pin

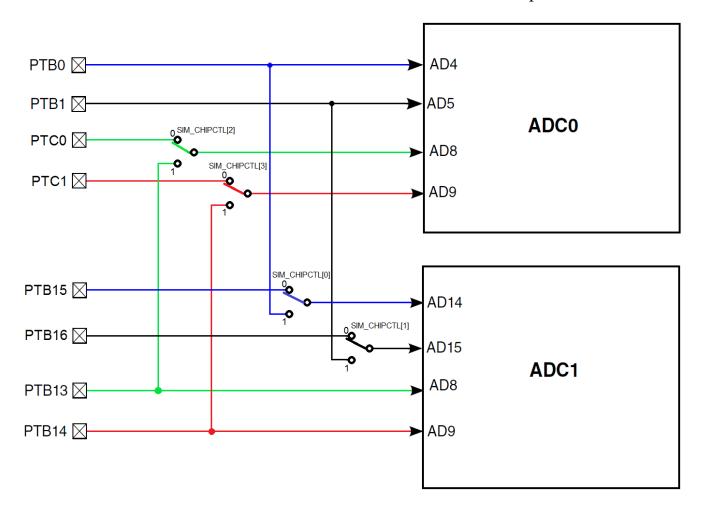


Figure 36-1. ADC0 and ADC1 hardware interleaved channels integration

36.1.4.2 ADC Reference Options

The ADC supports the following references:

• VREFH/VREFL - connected as the primary reference option

NOTE

VREFH pin on the PCB should use 3 bypass capacitors in the range: $1 \mu F$, 100 nF and 1 nF. Capacitors should be placed to the VREFH pin as close as possible.

 Bandgap from PMC connected as the V_{ALT2} reference option. The V_{ALT2} input is also connected within the ADC module as ADC channel 27

ADCx_SC2[REFSEL] bit selects the voltage reference sources for ADC. Refer to REFSEL description in ADC chapter for more details.

36.1.4.3 ADC Trigger Sources

The ADC support multiple trigger sources. There is two kinds of trigger: pre-trigger and trigger. The pre-trigger precondition the ADC block and selects the specific data result register, before the ADC trigger is asserted. The trigger initiate the ADC conversion as soon as it's asserted. The trigger and pre-trigger sources are described as following:

- Hardware pre-triggers/triggers are connected through PDB and TRGMUX. The pre-triggers can also be controlled by software to provide flexible trigger schemes (by controlling SIM_ADCOPT[ADCxSWPRETRG] registers). Besides the hardware triggers through ADHWT, the ADC module itself also supports software trigger mode by setting SC2[ADTRG]=0. Following a write to SC1A register, a conversion is initiated.
- 1×PDB can generate triggers and pre-triggers for 2×ADC, each PDB channel will have up to 2 pre-triggers for ADC channel control, which provides an automatically trigger scheme so that the CPU involvement is not necessary.
- TRGMUX can provide triggers for each ADC, while the pre-triggers need to be controlled by software to determine relative priority. It should not trigger the ADC again before a single conversion has not completed.

The following triggers are via the TRGMUX:

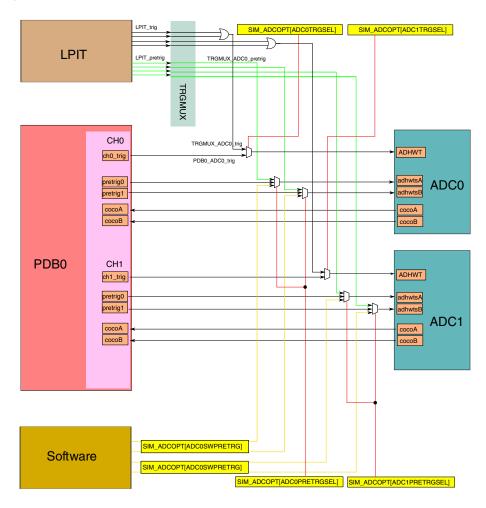
- CMP out to trigger each ADC
- LPIT capable to trigger each ADC, LPIT supports up to 4 pre-triggers, two are for ADC0 ADHWTSA~ADHWTSB and the another two are for ADC1 ADHWTSA~ADHWTSB.
- RTC capable to trigger each ADC
- LPTMR capable to trigger each ADC
- Software trigger capable to trigger each ADC

NOTE

The software trigger/pre-trigger through TRGMUX, the ADC's own software trigger mode and the software pretrigger controlled by SIM are different concepts.

Following specification and diagram are just giving an example to help understanding the ADC trigger scheme. Generally, the ADC support two kind of hardware triggering scheme:

- The default hardware triggering scheme is using PDB to trigger ADC (suggested).
- Another optional hardware triggering scheme is using TRGMUX.
- SIM_ADCOPT[ADCxTRGSEL] bit is used to control the ADC triggering source/ scheme.
 - When ADCxTRGSEL=0, the ADC pre-trigger is coming from PDB directly.
 - When ADCxTRGSEL=1, the ADC pre-trigger is coming from TRGMUX, e.g. LPIT.



PDB triggering scheme:

734 NXP Semiconductors

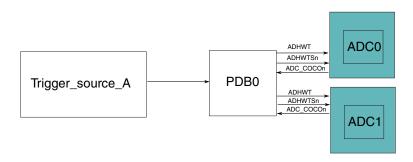
735

PDB triggering scheme is the default and suggested trigger method for ADC. Two ADC and one PDB work as one pair, the implementation on this device is: PDB0-ADC0 and ADC1. Here we take PDB0-ADC0 and ADC1 as an example to specify the triggering scheme.

- Set SIM_ADCOPT[ADCxTRGSEL]=0. PDB0 channel0 and channel1 is selected as ADC trigger source.
- Set SIM_ADCOPT[ADCxPRETRGSEL]=00. PDB0 pre-triggers will connect directly to ADC0 and ADC1 ADHWTS ports to control the channels.
- The ADC0 and ADC1 COCO signals are directly feed-backed to PDB0 to deactivate the PDB lock state.

Following are typical case for ADC triggering using PDB:

Case 1:



TRGMUX triggering scheme:

TRGMUX supports many trigger sources, here we take LPIT as an example (typical), but the trigger source can also be others which mentioned above. LPIT supports up to 4 channels, each channel have a trigger and pre-trigger.

- Set SIM_ADCOPT[ADCxTRGSEL]=1. TRGMUX out is selected as ADC trigger source.
- Configure TRGMUX to select LPIT triggers as ADC trigger and pre-trigger source.
- Set SIM_ADCOPT[ADCxPRETRGSEL]=01. LPIT pre-triggers will connect directly to ADC0 and ADC1 ADHWTS ports to control the channels.
- ADC COCO is not required in this case. Software need to take care of the intermission time between each ADC conversion.
- With TRGMUX, a single LPIT could be used to trigger 2 ADCs at same time. This is one of the benefits for TRGMUX triggering, compared with PDB triggering.

NOTE

For other trigger sources other than PDB and LPIT, software engagement is required to configure ADC pre-trigger selection. That means it must select pre-trigger source from software (it is required SIM_ADCOPT[ADCxPRETRGSEL] is set to 10 in this case, to make sure that software pre-triggers connect directly to ADC0 and ADC1 ADHWTS ports), and which ADC channel to use (by setting ADCxSWPRETRG).

Software triggering scheme:

It also supports to configure ADC pre-trigger/trigger by software.

• By setting SC2[ADTRG]=0, ADC software trigger mode is selected. A conversion is initiated following a write to SC1A register.

NOTE

ADC software trigger mode only support SC1A and data register A.

• Configure SC2[ADTRG]=1, ADC is in hardware triggering mode. By setting SIM_ADCOPT[ADCxSWPRETRG], the pre-trigger for ADC is selected. The software trigger trough TRGMUX can trigger the ADC conversion. This mechanism supports multiple data registers.

36.2 Introduction

The 12-bit analog-to-digital converter (ADC) is a successive approximation ADC designed for operation within an integrated microcontroller system-on-chip.

NOTE

For the chip specific modes of operation, see the power management information of the device.

36.2.1 Features

Following are the features of the ADC module:

- Linear successive approximation algorithm with up to 12-bit resolution
- Up to 16 single-ended external analog inputs
- Output modes:

737

- single-ended 12-bit, 10-bit, and 8-bit modes
- Output in right-justified unsigned format for single-ended
- Single or continuous conversion modes
- Automatic return to idle after single conversion
- Configurable sample time and conversion speed/power
- Conversion complete/hardware average complete flag and interrupt
- Input clock selectable from up to four sources
- Operation in low-power modes for lower noise
- Selectable hardware conversion trigger with hardware channel select
- Automatic compare with interrupt for less-than, greater-than or equal-to, within range, or out-of-range, programmable value
- Temperature sensor
- Hardware average function
- Selectable voltage reference: external or alternate
- Self-Calibration mode

36.2.2 Block diagram

The following figure is the ADC module block diagram.

ADC signal descriptions

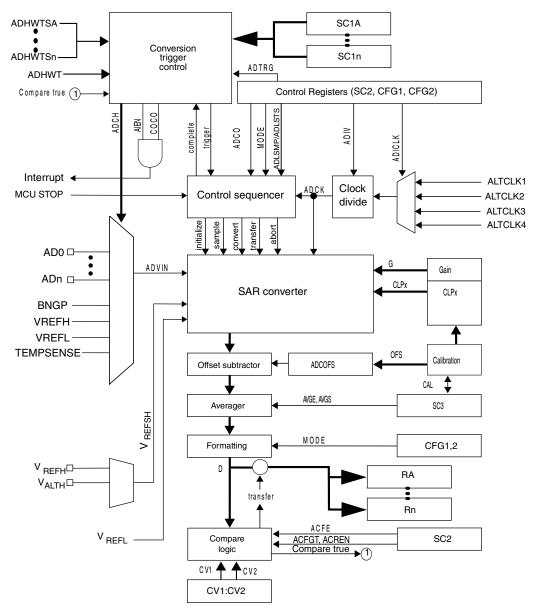


Figure 36-2. ADC block diagram

36.3 ADC signal descriptions

Each ADC module supports up to 16 single-ended inputs.

The ADC also requires four supply/reference/ground connections.

NOTE

For the number of channels supported on this device, see the chip-specific ADC information.

The ADC does not produce any output signals.

739

Table 36-4. ADC input signal descriptions

Signal	Description
ADn	Single-Ended Analog Channel Inputs
V _{REFSH}	Voltage Reference Select High
V _{REFSL}	Voltage Reference Select Low
V_{DDA}	Analog Power Supply
V _{SSA}	Analog Ground

36.3.1 Analog Power (V_{DDA})

The ADC analog portion uses V_{DDA} as its power connection. In some packages, V_{DDA} is connected internally to V_{DD} . If externally available, connect the V_{DDA} pin to the same voltage potential as V_{DD} . External filtering may be necessary to ensure clean V_{DDA} for good results.

36.3.2 Analog Ground (V_{SSA})

The ADC analog portion uses V_{SSA} as its ground connection. In some packages, V_{SSA} is connected internally to V_{SS} . If externally available, connect the V_{SSA} pin to the same voltage potential as V_{SS} .

36.3.3 Voltage Reference Select

V_{REFSH} and V_{REFSL} are the high and low reference voltages for the ADC module.

The ADC can be configured to accept one of the voltage reference pairs for V_{REFSH} and V_{REFSL} by configuring V_{REFSH} as V_{REFH} or V_{VALTH} . Each pair contains a positive reference that must be between the minimum Ref Voltage High and V_{DDA} , and a ground reference that must be at the same potential as V_{SSA} . The two pairs are external (V_{REFH} and V_{REFL}) alternate (V_{ALTLH} and V_{REFL}). These voltage references are selected using SC2[REFSEL]. The alternate voltage reference, V_{ALTH} may select additional external pin or internal source depending on MCU configuration. See the chip configuration information on the Voltage References specific to this MCU.

Memory map and register definitions

In some packages, V_{REFH} is connected in the package to V_{DDA} and V_{REFL} to V_{SSA} . If externally available, the positive reference(s) may be connected to the same potential as V_{DDA} or may be driven by an external source to a level between the minimum Ref Voltage High and the V_{DDA} potential. V_{REFH} must never exceed V_{DDA} . Connect the ground references to the same voltage potential as V_{SSA} .

36.3.4 Analog Channel Inputs (ADx)

The ADC module supports up to 16 analog inputs. An analog input is selected for conversion through the SC1[ADCH] channel select field.

36.4 Memory map and register definitions

This section describes the ADC registers.

NOTE

The reset values of ADC Calibration and Gain registers are loaded from IFR.

ADC memory map

Absolute address (hex)	Register name	Width (in bits)	Access Reset value		Section/ page
4002_7000	ADC Status and Control Register 1 (ADC1_SC1A)	32	R/W	0000_001Fh	36.4.1/742
4002_7004	ADC Status and Control Register 1 (ADC1_SC1B)	32	R/W	0000_001Fh	36.4.1/742
4002_7040	ADC Configuration Register 1 (ADC1_CFG1)	32	R/W	0000_0000h	36.4.2/745
4002_7044	ADC Configuration Register 2 (ADC1_CFG2)	32	R/W	0000_000Ch	36.4.3/746
4002_7048	ADC Data Result Registers (ADC1_RA)	32	R	0000_0000h	36.4.4/747
4002_704C	ADC Data Result Registers (ADC1_RB)	32	R	0000_0000h	36.4.4/747
4002_7088	Compare Value Registers (ADC1_CV1)	32	R/W	0000_0000h	36.4.5/748
4002_708C	Compare Value Registers (ADC1_CV2)	32	R/W	0000_0000h	36.4.5/748
4002_7090	Status and Control Register 2 (ADC1_SC2)	32	R/W	0000_0000h	36.4.6/749
4002_7094	Status and Control Register 3 (ADC1_SC3)	32	R/W	0000_0000h	36.4.7/751
4002_7098	BASE Offset Register (ADC1_BASE_OFS)	32	R/W	0000_0040h	36.4.8/752
4002_709C	ADC Offset Correction Register (ADC1_OFS)	32	R/W	0000_0000h	36.4.9/752
4002_70A0	USER Offset Correction Register (ADC1_USR_OFS)	32	R/W	0000_0000h	36.4.10/ 753
4002_70A4	ADC X Offset Correction Register (ADC1_XOFS)	32	R/W	0000_0030h	36.4.11/ 754
4002_70A8	ADC Y Offset Correction Register (ADC1_YOFS)	32	R/W	0000_0037h	36.4.12/ 754

Table continues on the next page...

ADC memory map (continued)

Absolute address (hex)	Register name		Access	Reset value	Section/ page
4002_70AC	ADC Gain Register (ADC1_G)	32	R/W	0000_02F0h	36.4.13/ 754
4002_70B0	ADC User Gain Register (ADC1_UG)	32	R/W	0000_0004h	36.4.14/ 755
4002_70B4	ADC General Calibration Value Register S (ADC1_CLPS)	32	R/W	See section	36.4.15/ 755
4002_70B8	ADC Plus-Side General Calibration Value Register 3 (ADC1_CLP3)	32	R/W	See section	36.4.16/ 756
4002_70BC	ADC Plus-Side General Calibration Value Register 2 (ADC1_CLP2)	32	R/W	See section	36.4.17/ 757
4002_70C0	ADC Plus-Side General Calibration Value Register 1 (ADC1_CLP1)	32	R/W	See section	36.4.18/ 757
4002_70C4	ADC Plus-Side General Calibration Value Register 0 (ADC1_CLP0)	32	R/W	See section	36.4.19/ 758
4002_70C8	ADC Plus-Side General Calibration Value Register X (ADC1_CLPX)	32	R/W	See section	36.4.20/ 758
4002_70CC	ADC Plus-Side General Calibration Value Register 9 (ADC1_CLP9)	32	R/W	See section	36.4.21/ 759
4002_70D0	ADC General Calibration Offset Value Register S (ADC1_CLPS_OFS)	32	R/W	0000_0000h	36.4.22/ 760
4002_70D4	ADC Plus-Side General Calibration Offset Value Register 3 (ADC1_CLP3_OFS)	32	R/W	0000_0000h	36.4.23/ 760
4002_70D8	ADC Plus-Side General Calibration Offset Value Register 2 (ADC1_CLP2_OFS)	32	R/W	0000_0000h	36.4.24/ 761
4002_70DC	ADC Plus-Side General Calibration Offset Value Register 1 (ADC1_CLP1_OFS)	32	R/W	0000_0000h	36.4.25/ 761
4002_70E0	ADC Plus-Side General Calibration Offset Value Register 0 (ADC1_CLP0_OFS)	32	R/W	0000_0000h	36.4.26/ 761
4002_70E4	ADC Plus-Side General Calibration Offset Value Register X (ADC1_CLPX_OFS)	32	R/W	0000_0440h	36.4.27/ 762
4002_70E8	ADC Plus-Side General Calibration Offset Value Register 9 (ADC1_CLP9_OFS)	32	R/W	0000_0240h	36.4.28/ 762
4003_B000	ADC Status and Control Register 1 (ADC0_SC1A)	32	R/W	0000_001Fh	36.4.1/742
4003_B004	ADC Status and Control Register 1 (ADC0_SC1B)	32	R/W	0000_001Fh	36.4.1/742
4003_B040	ADC Configuration Register 1 (ADC0_CFG1)	32	R/W	0000_0000h	36.4.2/745
4003_B044	ADC Configuration Register 2 (ADC0_CFG2)	32	R/W	0000_000Ch	36.4.3/746
4003_B048	ADC Data Result Registers (ADC0_RA)	32	R	0000_0000h	36.4.4/747
4003_B04C	ADC Data Result Registers (ADC0_RB)	32	R	0000_0000h	36.4.4/747
4003_B088	Compare Value Registers (ADC0_CV1)	32	R/W	0000_0000h	36.4.5/748
4003_B08C	Compare Value Registers (ADC0_CV2)	32	R/W	0000_0000h	36.4.5/748
4003_B090	Status and Control Register 2 (ADC0_SC2)	32	R/W	0000_0000h	36.4.6/749
4003_B094	Status and Control Register 3 (ADC0_SC3)	32	R/W	0000_0000h	36.4.7/751
4003_B098	BASE Offset Register (ADC0_BASE_OFS)	32	R/W	0000_0040h	36.4.8/752

Table continues on the next page...

Memory map and register definitions

ADC memory map (continued)

Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page
4003_B09C	ADC Offset Correction Register (ADC0_OFS)	32	R/W	0000_0000h	36.4.9/752
4003_B0A0	USER Offset Correction Register (ADC0_USR_OFS)	32	R/W	0000_0000h	36.4.10/ 753
4003_B0A4	ADC X Offset Correction Register (ADC0_XOFS)	32	R/W	0000_0030h	36.4.11/ 754
4003_B0A8	ADC Y Offset Correction Register (ADC0_YOFS)	32	R/W	0000_0037h	36.4.12/ 754
4003_B0AC	ADC Gain Register (ADC0_G)	32	R/W	0000_02F0h	36.4.13/ 754
4003_B0B0	ADC User Gain Register (ADC0_UG)	32	R/W	0000_0004h	36.4.14/ 755
4003_B0B4	ADC General Calibration Value Register S (ADC0_CLPS)	32	R/W	See section	36.4.15/ 755
4003_B0B8	ADC Plus-Side General Calibration Value Register 3 (ADC0_CLP3)	32	R/W	See section	36.4.16/ 756
4003_B0BC	ADC Plus-Side General Calibration Value Register 2 (ADC0_CLP2)	32	R/W	See section	36.4.17/ 757
4003_B0C0	ADC Plus-Side General Calibration Value Register 1 (ADC0_CLP1)	32	R/W	See section	36.4.18/ 757
4003_B0C4	ADC Plus-Side General Calibration Value Register 0 (ADC0_CLP0)	32	R/W	See section	36.4.19/ 758
4003_B0C8	ADC Plus-Side General Calibration Value Register X (ADC0_CLPX)	32	R/W	See section	36.4.20/ 758
4003_B0CC	ADC Plus-Side General Calibration Value Register 9 (ADC0_CLP9)	32	R/W	See section	36.4.21/ 759
4003_B0D0	ADC General Calibration Offset Value Register S (ADC0_CLPS_OFS)	32	R/W	0000_0000h	36.4.22/ 760
4003_B0D4	ADC Plus-Side General Calibration Offset Value Register 3 (ADC0_CLP3_OFS)	32	R/W	0000_0000h	36.4.23/ 760
4003_B0D8	ADC Plus-Side General Calibration Offset Value Register 2 (ADC0_CLP2_OFS)	32	R/W	0000_0000h	36.4.24/ 761
4003_B0DC	ADC Plus-Side General Calibration Offset Value Register 1 (ADC0_CLP1_OFS)	32	R/W	0000_0000h	36.4.25/ 761
4003_B0E0	ADC Plus-Side General Calibration Offset Value Register 0 (ADC0_CLP0_OFS)	32	R/W	0000_0000h	36.4.26/ 761
4003_B0E4	ADC Plus-Side General Calibration Offset Value Register X (ADC0_CLPX_OFS)	32	R/W	0000_0440h	36.4.27/ 762
4003_B0E8	ADC Plus-Side General Calibration Offset Value Register 9 (ADC0_CLP9_OFS)	32	R/W	0000_0240h	36.4.28/ 762

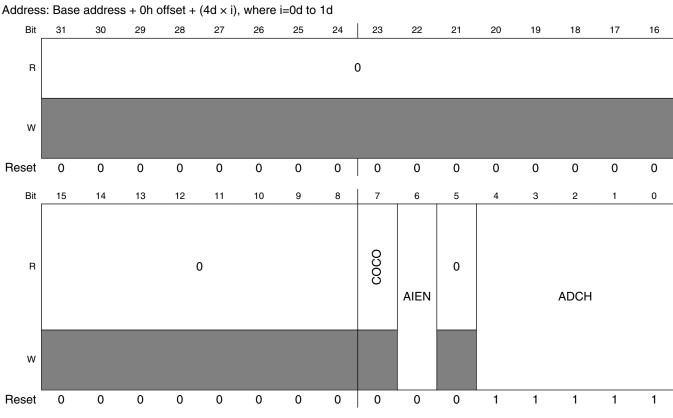
36.4.1 ADC Status and Control Register 1 (ADCx_SC1n)

SC1A is used for both software and hardware trigger modes of operation.

At any one point in time, only one of the SC1n registers is actively controlling ADC sequential conversions. Updating SC1A while SC1n is actively controlling a conversion is allowed, and vice versa for any of the SC1n registers specific to this MCU.

Writing SC1A while SC1A is actively controlling a conversion aborts the current conversion. In Software Trigger mode (when SC2[ADTRG] = 0), writes to SC1A initiate a new conversion. This is valid for all values of SC1A[ADCH] other than 11111 (module disabled)."

Writing any of the SC1*n* registers while that specific SC1*n* register is actively controlling a conversion aborts the current conversion. None of the SC1B-SC1*n* registers are used for software trigger operation and therefore writes to the SC1B-SC1*n* registers do not initiate a new conversion.



ADCx_SC1n field descriptions

Field	Description	
31–8 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.	
7 COCO	Conversion Complete Flag	
	This is a read-only field that is set each time a conversion is completed when one or more of the following is true: • The compare function is disabled	

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Memory map and register definitions

ADCx_SC1n field descriptions (continued)

Field	Description
	 SC2[ACFE]=0 and the hardware average function is disabled SC3[AVGE]=0
	If the compare result is true, then COCO is set upon completion of a conversion if one or more of the following is true: • The compare function is enabled • SC2[ACFE]=1
	COCO is set upon completion of the selected number of conversions (determined by AVGS) if one or more of the following is true: • The hardware average function is enabled • SC3[AVGE]=1
	COCO in SC1A is also set at the completion of a calibration sequence.
	COCO is cleared when one of the following is true: • The respective SC1n register is written • The respective Rn register is read
	0 Conversion is not completed.1 Conversion is completed.
6	Interrupt Enable
AIEN	Enables conversion complete interrupts. When COCO becomes set while the respective AIEN is high, an interrupt is asserted.
	Conversion complete interrupt is disabled.Conversion complete interrupt is enabled.
5 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
ADCH	Input channel select
	Selects one of the input channels.
	NOTE: Some of the input channel options in the bitfield-setting descriptions might not be available for your chip. For the actual ADC channel assignments for your device, see the chip-specific information.
	The successive approximation converter subsystem is turned off when the channel bits are all set (i.e. ADCH set to all 1s). This feature allows explicit disabling of the ADC and isolation of the input channel from all sources. Terminating continuous conversions this way prevents an additional single conversion from being performed. It is not necessary to set ADCH to all 1s to place the ADC in a low-power state when continuous conversions are not enabled because the module automatically enters a low-power state when a conversion completes.
	00000 Exernal channel 0 is selected as input.
	00001 Exernal channel 1 is selected as input. 00010 Exernal channel 2 is selected as input.
	00010 Exernal channel 2 is selected as input. 00011 Exernal channel 3 is selected as input.
	00100 Exernal channel 4 is selected as input.
	00101 Exernal channel 5 is selected as input.
	00110 Exernal channel 6 is selected as input.
	00111 Exernal channel 7 is selected as input. 01000 Exernal channel 8 is selected as input.
	01000 Exernal channel 8 is selected as input.

Table continues on the next page...

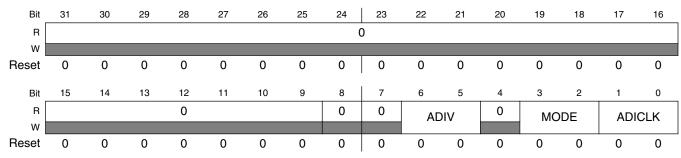
ADCx_SC1n field descriptions (continued)

Field		Description
	01001	Exernal channel 9 is selected as input.
	01010	Exernal channel 10 is selected as input.
	01011	Exernal channel 11 is selected as input.
	01100	Exernal channel 12 is selected as input.
	01101	Exernal channel 13 is selected as input.
	01110	Exernal channel 14 is selected as input.
	01111	Exernal channel 15 is selected as input.
	10000	Reserved
	10001	Reserved
	10010	Exernal channel 18 is selected as input.
	10011	Exernal channel 19 is selected as input.
	10100	Reserved.
	10101	Internal channel 0 is selected as input.
	10110	Internal channel 1 is selected as input.
	10111	Internal channel 2 is selected as input.
	11000	Reserved
	11001	Reserved
	11010	Temp Sensor
	11011	Band Gap
	11100	Internal channel 3 is selected as input.
	11101	V _{REFSH} is selected as input. Voltage reference selected is determined by SC2[REFSEL].
	11110	V _{REFSL} is selected as input. Voltage reference selected is determined by SC2[REFSEL].
	11111	Module is disabled

36.4.2 ADC Configuration Register 1 (ADCx_CFG1)

Configuration Register 1 (CFG1) selects the mode of operation, clock source, clock divide.





ADCx_CFG1 field descriptions

Field	Description
	This field is reserved. This read-only field is reserved and always has the value 0.

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Memory map and register definitions

ADCx_CFG1 field descriptions (continued)

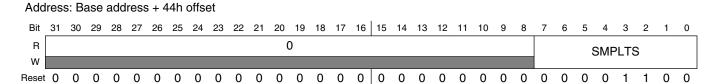
Field	Description			
8 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.			
7 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.			
6–5 ADIV	Clock Divide Select			
	Selects the divide ratio used by the ADC to generate the internal clock ADCK.			
	00 The divide ratio is 1 and the clock rate is input clock.			
	01 The divide ratio is 2 and the clock rate is (input clock)/2.			
	10 The divide ratio is 4 and the clock rate is (input clock)/4.			
	11 The divide ratio is 8 and the clock rate is (input clock)/8.			
4	This field is reserved.			
Reserved	This read-only field is reserved and always has the value 0.			
3–2	Conversion mode selection			
MODE	Selects the ADC resolution.			
	00 8-bit conversion.			
	01 12-bit conversion.			
	10 10-bit conversion.			
	11 Reserved			
ADICLK	Input Clock Select			
	Selects the input clock source to generate the internal clock, ADCK. See the clock distribution/clocking chapter of your device for details on which alternate clocks are supported.			
	00 Alternate clock 1 (ADC_ALTCLK1)			
	01 Alternate clock 2 (ADC_ALTCLK2)			
	10 Alternate clock 3 (ADC_ALTCLK3)			
	11 Alternate clock 4 (ADC_ALTCLK4)			

36.4.3 ADC Configuration Register 2 (ADCx_CFG2)

Configuration Register 2 (CFG2) selects the long sample time duration during long sample mode.

NOTE

Writing 0 is not supported on this register.



ADCx_CFG2 field descriptions

Field	Description
31–8 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
SMPLTS	Sample Time Select Selects a sample time of 2 to 256 ADCK clock cycles. The value written to this register field is the desired sample time minus 1. A sample time of 1 is not supported. Allows higher impedance inputs to be accurately sampled or conversion speed to be maximized for lower impedance inputs. Longer sample times can also be used to lower overall power consumption when continuous conversions are enabled if high conversion rates are not required.

36.4.4 ADC Data Result Registers (ADCx_Rn)

Rn contains the result of an ADC conversion of the channel selected by the corresponding SC1A:SC1n. For every status and channel control register, there is a corresponding data result register.

Unused bits in Rn are cleared.

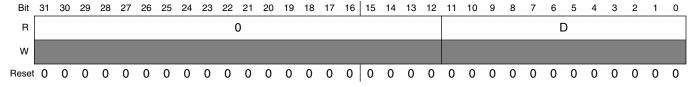
The following table describes the behavior of the data result registers in the different modes of operation.

Table 36-5. Data result register description

Conversion mode	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0	Format
12-bit single-ended						D							Unsigned right-
10-bit single-ended	())					justified
8-bit single-ended	0				D								

D: Data. The data result registers are read-only; writing to these registers generates a transfer error.

Address: Base address + 48h offset + $(4d \times i)$, where i=0d to 1d



ADCx_Rn field descriptions

Field	Description			
31–12 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.			
D	Data result			

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

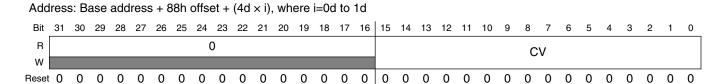
0 0 0 0 0

Compare Value Registers (ADCx CVn) 36.4.5

0

The Compare Value Registers (CV1 and CV2) contain a compare value used to compare the conversion result when the compare function is enabled, that is, SC2[ACFE]=1. This register is formatted in the same way as the Rn registers. Therefore, the compare function uses only the CVn fields that are related to the ADC mode of operation.

CV2 is used only when the compare range function is enabled, that is, SC2[ACREN]=1.



0

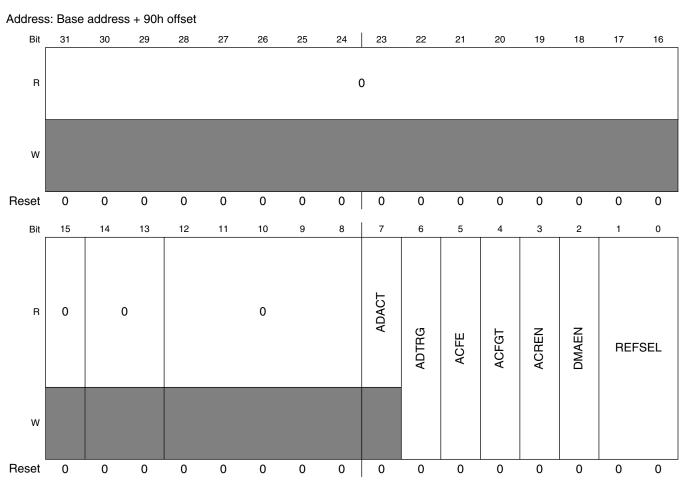
ADCx_CVn field descriptions

0

Field	Description				
31–16 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.				
CV	Compare Value.				

36.4.6 Status and Control Register 2 (ADCx_SC2)

The status and control register 2 (SC2) contains the conversion active, hardware/software trigger select, compare function, and voltage reference select of the ADC module.



ADCx_SC2 field descriptions

Field	Description
31–16 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
15 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
14–13 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
12–8 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
7 ADACT	Conversion Active Indicates that a conversion or hardware averaging is in progress. ADACT is set when a conversion is initiated and cleared when a conversion is completed or aborted.

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

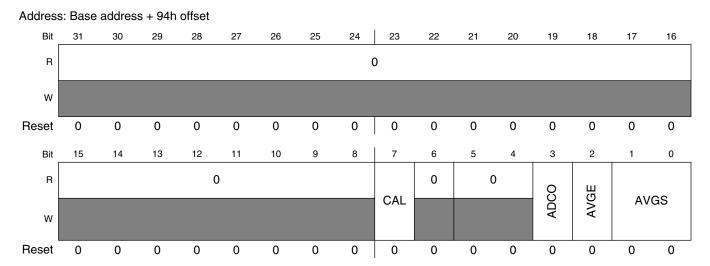
Memory map and register definitions

ADCx_SC2 field descriptions (continued)

Field	Description				
	0 Conversion not in progress.				
	1 Conversion in progress.				
6 ADTRG	Conversion Trigger Select				
	 Selects the type of trigger used for initiating a conversion. Two types of triggers can be selected: Software trigger: When software trigger is selected, a conversion is initiated following a write to SC1A. Hardware trigger: When hardware trigger is selected, a conversion is initiated following the assertion of the ADHWT input after a pulse of the ADHWTSn input. 				
	0 Software trigger selected.				
	1 Hardware trigger selected.				
5	Compare Function Enable				
ACFE	Enables the compare function.				
	0 Compare function disabled.				
	1 Compare function enabled.				
4 ACFGT	Compare Function Greater Than Enable				
	Configures the compare function to check the conversion result relative to CV1 and CV2 based upon the value of ACREN. ACFE must be set for ACFGT to have any effect. See Table 36-7 "Compare modes" for further details.				
3 ACREN	Compare Function Range Enable				
AOREN	Configures the compare function to check if the conversion result of the input being monitored is either between or outside the range formed by CV1 and CV2 determined by the value of ACFGT. ACFE must be set for ACFGT to have any effect. See Table 36-7 "Compare modes" for further details.				
2	DMA Enable				
DMAEN	0 DMA is disabled.				
	DMA is enabled and will assert the ADC DMA request during an ADC conversion complete event , which is indicated when any SC1n[COCO] flag is asserted.				
REFSEL	Voltage Reference Selection				
	Selects the voltage reference source used for conversions.				
	00 Default voltage reference pin pair, that is, external pins V _{REFH} and V _{REFL}				
	O1 Alternate reference voltage, that is, V _{ALTH} . This voltage may be additional external pin or internal source depending on the MCU configuration. See the chip configuration information for details specific to this MCU.				
	10 Reserved				
	11 Reserved				

36.4.7 Status and Control Register 3 (ADCx_SC3)

The Status and Control Register 3 (SC3) controls the calibration, continuous conversion, and hardware averaging functions of the ADC module.



ADCx_SC3 field descriptions

Field	Description				
31–8 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.				
7 CAL	Calibration When CAL=1, the ADC begins the calibration sequence. This field stays set while the calibration is in progress and is cleared when the calibration sequence is completed. After it is started, the calibration routine cannot be interrupted by writes to the ADC registers or the results will be invalid. Setting CAL will abort any current conversion. NOTE: For calibration, it is mandatory to use averaging and average number 32. NOTE: If several ADCs are on a device, they should be calibrated sequentially. No parallel calibrations of				
6	ADCs are allowed because they will disturb each other. This field is reserved.				
Reserved	This read-only field is reserved and always has the value 0.				
5–4 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.				
3 ADCO	Continuous Conversion Enable Enables continuous conversions. One conversion will be performed (or one set of conversions, if AVGE is set) after a conversion is initiated. Continuous conversions will be performed (or continuous sets of conversions, if AVGE is set) after a conversion is initiated.				
2 AVGE	Hardware Average Enable				

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Memory map and register definitions

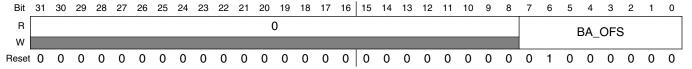
ADCx_SC3 field descriptions (continued)

Field	Description				
	Enables the hardware average function of the ADC.				
	0 Hardware average function disabled.				
	1 Hardware average function enabled.				
AVGS	Hardware Average Select				
	Determines how many ADC conversions will be averaged to create the ADC average result.				
	00 4 samples averaged.				
	01 8 samples averaged.				
	10 16 samples averaged.				
	11 32 samples averaged.				

36.4.8 BASE Offset Register (ADCx_BASE_OFS)

The BASE Offset Register (BASE_OFS) contains the offset value used by the calibration algorithm to determine the Offset Calibration Value (OFS).





ADCx_BASE_OFS field descriptions

Field	Description		
31–8 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.		
BA_OFS	Base Offset Error Correction Value		

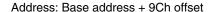
36.4.9 ADC Offset Correction Register (ADCx_OFS)

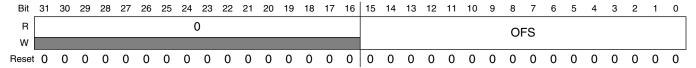
The ADC Offset Correction Register (OFS) contains the calibration-generated offset error correction value (OFS). The value in BA_OFS is used in the calibration algorithm to calculate the offset correction value that gets stored in the OFS register. The value in OFS is subtracted from the conversion and the result is transferred into the result registers, Rn. If the result is greater than the maximum or less than the minimum result value, it is forced to the appropriate limit for the current mode of operation.

753

NOTE

If offset register is set to a negative value and it is lower than or equal to 0xFFF8, the ADC will not result code 0. If offset register is set to a negative value and it is lower than or equal to 0xFFF0, the ADC will not result code 1.





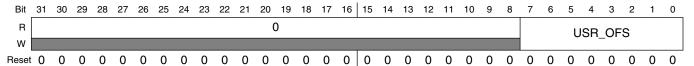
ADCx_OFS field descriptions

Field	Description			
31–16 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.			
OFS	Offset Error Correction Value			

36.4.10 USER Offset Correction Register (ADCx_USR_OFS)

The ADC USER Offset Correction Register (USR_OFS) contains the user defined offset error correction value used in the conversion result error correction algorithm.

Address: Base address + A0h offset

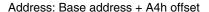


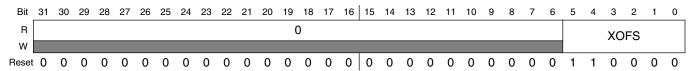
ADCx_USR_OFS field descriptions

Field	Description			
31–8 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.			
USR_OFS	USER Offset Error Correction Value			

ADC X Offset Correction Register (ADCx XOFS) 36.4.11

The ADC X Offset Correction Register (XOFS) contains the X offset used in the conversion result error correction algorithm.





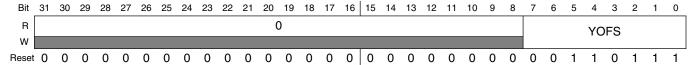
ADCx_XOFS field descriptions

Field	Description			
31–6 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.			
XOFS	X offset error correction value			

36.4.12 ADC Y Offset Correction Register (ADCx YOFS)

The ADC Y Offset Correction Register (YOFS) contains the Y offset used in the conversion result error correction algorithm.

Address: Base address + A8h offset



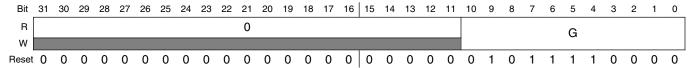
ADCx_YOFS field descriptions

Field	Description		
31–8 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.		
YOFS	Y offset error correction value		

36.4.13 ADC Gain Register (ADCx_G)

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018 754 NXP Semiconductors The Gain Register (G) contains the gain error correction for the overall conversion. G, a 11-bit real number in binary format, is the gain adjustment factor. This register value is determined and uploaded by the calibration algorithm.





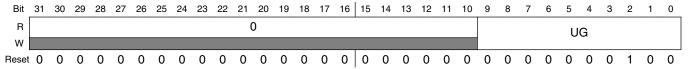
ADCx_G field descriptions

Field	Description
31–11 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
G	Gain error adjustment factor for the overall conversion

36.4.14 ADC User Gain Register (ADCx_UG)

The User Gain Register (UG) contains the user gain error correction. It allows you to adjust the final calibration gain value.

Address: Base address + B0h offset



ADCx_UG field descriptions

Field	Description
31–10 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
UG	User gain error correction value

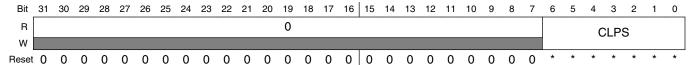
36.4.15 ADC General Calibration Value Register S (ADCx_CLPS)

The General Calibration Value Registers (CLPx) contain calibration information that is generated by the calibration function. These registers contain seven signed calibration values of varying widths in two's complement format. CLPx are automatically set when the self-calibration sequence is done, that is, CAL is cleared. If these registers are written by the user after calibration, the linearity error specifications may not be met.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Memory map and register definitions

Address: Base address + B4h offset



^{*} Notes

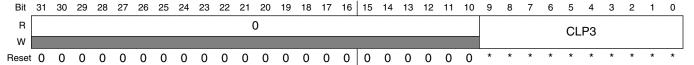
· CLPS field: Reset values are loaded out of IFR.

ADCx_CLPS field descriptions

Field	Description
31–7 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
CLPS	Calibration Value

36.4.16 ADC Plus-Side General Calibration Value Register 3 (ADCx_CLP3)

Address: Base address + B8h offset



^{*} Notes:

· CLP3 field: Reset values are loaded out of IFR.

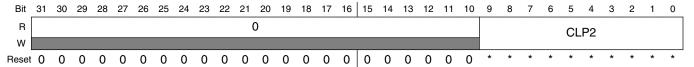
ADCx_CLP3 field descriptions

Field	Description
31–10 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
CLP3	Calibration Value

757

36.4.17 ADC Plus-Side General Calibration Value Register 2 (ADCx_CLP2)

Address: Base address + BCh offset



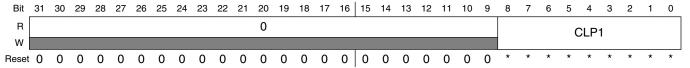
- * Notes:
- · CLP2 field: Reset values are loaded out of IFR.

ADCx_CLP2 field descriptions

Field	Description
31–10 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
CLP2	Calibration Value

36.4.18 ADC Plus-Side General Calibration Value Register 1 (ADCx_CLP1)

Address: Base address + C0h offset



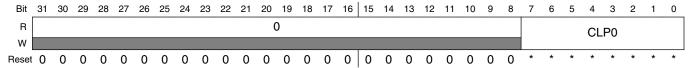
- * Notes:
- CLP1 field: Reset values are loaded out of IFR.

ADCx_CLP1 field descriptions

Field	Description
31–9 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
CLP1	Calibration Value

36.4.19 ADC Plus-Side General Calibration Value Register 0 (ADCx_CLP0)

Address: Base address + C4h offset



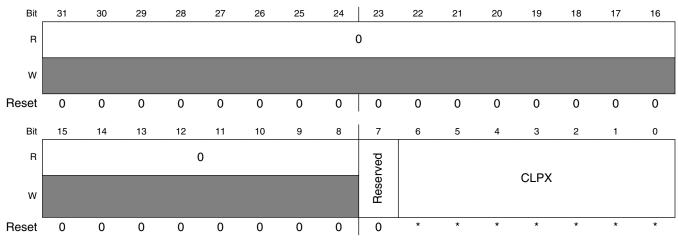
- * Notes:
- · CLP0 field: Reset values are loaded out of IFR.

ADCx_CLP0 field descriptions

Field	Description
31–8 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
CLP0	Calibration Value

36.4.20 ADC Plus-Side General Calibration Value Register X (ADCx_CLPX)

Address: Base address + C8h offset



- * Notes:
- · CLPX field: Reset values are loaded out of IFR.

ADCx_CLPX field descriptions

Field	Description
31–8	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.

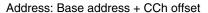
Table continues on the next page...

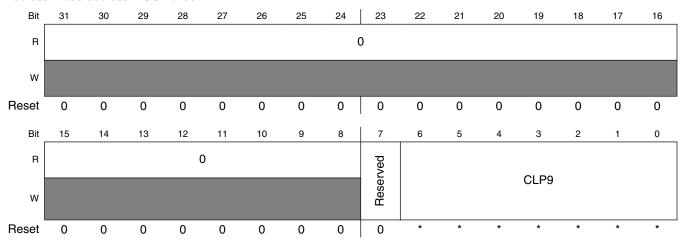
Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

ADCx_CLPX field descriptions (continued)

Field	Description
7 Reserved	This field is reserved.
CLPX	Calibration Value

36.4.21 ADC Plus-Side General Calibration Value Register 9 (ADCx_CLP9)





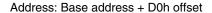
^{*} Notes:

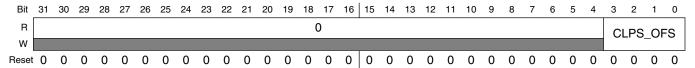
• CLP9 field: Reset values are loaded out of IFR.

ADCx_CLP9 field descriptions

Field	Description
31–8	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
7	This field is reserved.
Reserved	
CLP9	Calibration Value

36.4.22 ADC General Calibration Offset Value Register S (ADCx_CLPS_OFS)



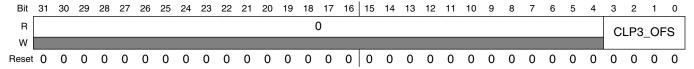


ADCx_CLPS_OFS field descriptions

Field	Description
31–4 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
	CLPS Offset
CLPS_OFS	Capacitor offset correction value

36.4.23 ADC Plus-Side General Calibration Offset Value Register 3 (ADCx_CLP3_OFS)

Address: Base address + D4h offset

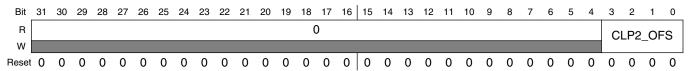


ADCx CLP3 OFS field descriptions

Field	Description
31–4 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
CLP3_OFS	CLP3 Offset
	Capacitor offset correction value

36.4.24 ADC Plus-Side General Calibration Offset Value Register 2 (ADCx_CLP2_OFS)

Address: Base address + D8h offset

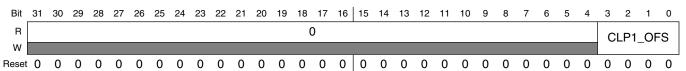


ADCx_CLP2_OFS field descriptions

Field	Description
31–4	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
CLP2_OFS	CLP2 Offset
	Capacitor offset correction value

36.4.25 ADC Plus-Side General Calibration Offset Value Register 1 (ADCx_CLP1_OFS)

Address: Base address + DCh offset

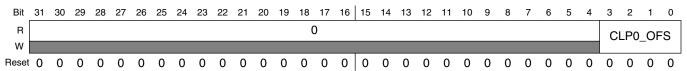


ADCx CLP1 OFS field descriptions

Field	Description
31–4 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
CLP1_OFS	CLP1 Offset
	Capacitor offset correction value

36.4.26 ADC Plus-Side General Calibration Offset Value Register 0 (ADCx CLP0 OFS)

Address: Base address + E0h offset



Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

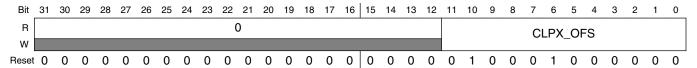
Memory map and register definitions

ADCx_CLP0_OFS field descriptions

Field	Description
31–4 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
CLP0_OFS	CLP0 Offset
	Capacitor offset correction value

36.4.27 ADC Plus-Side General Calibration Offset Value Register X (ADCx_CLPX_OFS)

Address: Base address + E4h offset

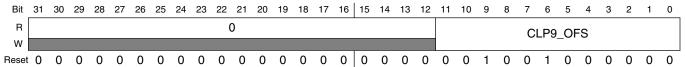


ADCx_CLPX_OFS field descriptions

Field	Description
31–12 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
CLPX_OFS	CLPX Offset
	Capacitor offset correction value

36.4.28 ADC Plus-Side General Calibration Offset Value Register 9 (ADCx_CLP9_OFS)

Address: Base address + E8h offset



ADCx_CLP9_OFS field descriptions

Field	Description					
-	This field is reserved. This read-only field is reserved and always has the value 0.					
neserveu	This redu-only field is reserved and always has the value o.					
CLP9_OFS	CLP9 Offset					
	Capacitor offset correction value					

763

36.5 Functional description

The ADC module is disabled during reset, or when SC1n[ADCH] are all high; see the power management information for details. The module is idle when a conversion has completed and another conversion has not been initiated. When it is idle the module is in its lowest power state. The ADC can perform an analog-to-digital conversion on any of the software selectable channels. All modes perform conversion by a successive approximation algorithm.

To meet accuracy specifications, the ADC module must be calibrated using the on-chip calibration function.

See Calibration function for details on how to perform calibration.

When the conversion is completed, the result is placed in the Rn data registers. The respective SC1n[COCO] is then set and an interrupt is generated if the respective conversion complete interrupt has been enabled, or when SC1n[AIEN]=1.

The ADC module has the capability of automatically comparing the result of a conversion with the contents of the CV1 and CV2 registers. The compare function is enabled by setting SC2[ACFE] and operates in any of the conversion modes and configurations.

The ADC module has the capability of automatically averaging the result of multiple conversions. The hardware average function is enabled by setting SC3[AVGE] and operates in any of the conversion modes and configurations.

NOTE

For the chip-specific modes of operation, see the power management information of this MCU.

36.5.1 Clock select and divide control

One of four clock sources can be selected as the clock source for the ADC module.

This clock source is then divided by a configurable value to generate the input clock ADCK, to the module. The clock is selected from one of the following sources by means of CFG1[ADICLK].

Functional description

• ALTCLKx: As defined for this MCU. See the chip configuration information. Conversions are possible using ALTCLKx as the input clock source while the MCU is in Normal Stop mode. ALTCLK1 is the default selection following reset.

Whichever clock is selected, its frequency must fall within the specified frequency range for ADCK. If the available clocks are too slow, the ADC may not perform according to specifications. If the available clocks are too fast, the clock must be divided to the appropriate frequency. This divider is specified by CFG1[ADIV] and can be divide-by 1, 2, 4, or 8. The ADC bus clock frequency must be greater than or equal to the ADC ALT clock frequency. Please refer to the device datasheet for the ADC specifications.

36.5.2 Voltage reference selection

The ADC can be configured to accept one of the two voltage reference pairs as the reference voltage (V_{REFSH} and V_{REFSL}) used for conversions.

Each pair contains a positive reference that must be between the minimum Ref Voltage High and V_{DDA} , and a ground reference that must be at the same potential as V_{SSA} . The two pairs are external (V_{REFH} and V_{REFL}) and alternate (V_{ALTH}). These voltage references are selected using SC2[REFSEL]. The alternate V_{ALTH} voltage reference may select additional external pin or internal source depending on MCU configuration. See the chip configuration information for the voltage references specific to this MCU.

36.5.3 Hardware trigger and channel selects

The ADC module has a selectable asynchronous hardware conversion trigger, ADHWT, that is enabled when SC2[ADTRG] is set and a hardware trigger select event, ADHWTSn, has occurred.

This source is not available on all MCUs. See the chip-specific ADC information for information on the ADHWT source and the ADHWTSn configurations specific to this MCU.

When an ADHWT source is available and hardware trigger is enabled, that is SC2[ADTRG]=1, a conversion is initiated on the rising edge of ADHWT after a hardware trigger select event, ADHWTSn, has occurred. If a conversion is in progress when a rising edge of a trigger occurs, the rising edge is ignored. In continuous conversionn configuration, only the initial rising edge to launch continuous conversions is observed, and until conversion is aborted, the ADC continues to do conversions on the same SCn register that initiated the conversion. The hardware trigger function operates in conjunction with any of the conversion modes and configurations.

765

The hardware trigger select event, ADHWTSn, must be set prior to the receipt of the ADHWT signal. If these conditions are not met, the converter may ignore the trigger or use an incorrect configuration. If a hardware trigger select event is asserted during a conversion, it must stay asserted until the end of current conversion and remain set until the receipt of the ADHWT signal to trigger a new conversion. The channel and status fields selected for the conversion depend on the active trigger select signal:

- ADHWTSA active selects SC1A.
- ADHWTSn active selects SC1n.

Note

Asserting more than one hardware trigger select signal (ADHWTSn) at the same time will cause unpredictable results. To avoid this, select only one hardware trigger select signal (ADHWTSn) prior to the next intended conversion.

When the conversion is completed, the result is placed in the Rn registers associated with the ADHWTSn received. For example:

- ADHWTSA active selects RA register
- ADHWTSn active selects Rn register

The conversion complete flag associated with the ADHWTSn received, that is, SC1n[COCO], is then set and an interrupt is generated if the respective conversion complete interrupt has been enabled, that is, SC1[AIEN]=1.

36.5.4 Conversion control

Conversions can be performed as determined by CFG1[MODE] as shown in the description of CFG1[MODE].

Conversions can be initiated by a software or hardware trigger.

In addition, the ADC module can be configured for:

- Low-power operation
- Long sample time
- Continuous conversion
- Hardware average
- Automatic compare of the conversion result to a software-determined compare value

36.5.4.1 Initiating conversions

A conversion is initiated:

Functional description

- Following a write to SC1A, if software-triggered operation is selected, that is, when SC2[ADTRG]=0.
- Following a hardware trigger, or ADHWT event, if hardware-triggered operation is selected, that is, SC2[ADTRG]=1, and a hardware trigger select event, ADHWTSn, has occurred. The channel and status fields that are selected depend on the active trigger select signal:
 - ADHWTSA active selects SC1A.
 - ADHWTSn active selects SC1n.
 - if neither is active, the off condition is selected

Note

Selecting more than one ADHWTSn prior to a conversion completion will cause unpredictable results. To avoid this, select only one ADHWTSn prior to a conversion completion.

• Following the transfer of the result to the data registers when continuous conversion is enabled, that is, when SC3[ADCO] = 1.

If continuous conversions are enabled, a new conversion is automatically initiated after the completion of the current conversion. In software-triggered operation, that is, when SC2[ADTRG] = 0, continuous conversions begin after SC1A is written and continue until aborted. In hardware-triggered operation, that is, when SC2[ADTRG] = 1 and one ADHWTSn event has occurred, continuous conversions begin after a hardware trigger event and continue until aborted.

If hardware averaging is enabled, a new conversion is automatically initiated after the completion of the current conversion until the correct number of conversions are completed. In software-triggered operation, conversions begin after SC1A is written. In hardware-triggered operation, conversions begin after a hardware trigger. If continuous conversions are also enabled, a new set of conversions to be averaged are initiated following the last of the selected number of conversions.

36.5.4.2 Completing conversions

A conversion is completed when the result of the conversion is transferred into the data result registers, Rn, as indicated in the following table.

Table 36-6. Indication of conversion completion

Compare functions	Hardware averaging	Conversion status	Is SC1n[COCO] set to 1, and is the conversion result transferred into the data result registers?	
Disabled	Disabled	Not completed	No	
Disabled	Disabled	Completed	Yes	
Disabled	Enabled	Not completed	No	
Disabled	Enabled	Completed	Yes, if the last of the selected number of conversions is completed	
Enabled	Disabled	Not completed	No	
Enabled	Disabled	Completed	Yes, if the compare condition is true	
Enabled	Enabled	Not completed	No	
Enabled	Enabled	Completed	Yes, if [(the last of the selected number of conversions is completed) AND (the compare condition is true)]	

An interrupt is generated if the respective SC1n[AIEN] is high at the time that the respective SC1n[COCO] is set.

36.5.4.3 Aborting conversions

Any conversion in progress is aborted when:

- Writing to SC1A while it is actively controlling a conversion aborts the current conversion. In Software Trigger mode, when SC2[ADTRG]=0, a write to SC1A initiates a new conversion if SC1A[ADCH] is equal to a value other than all 1s. Writing to any of the SC1B-SC1n registers while that specific SC1B-SC1n register is actively controlling a conversion aborts the current conversion. The SC1(B-n) registers are not used for software trigger operation and therefore writes to the SC1(B-n) registers do not initiate a new conversion.
- A write to any ADC register besides the SC1A-SC1n registers occurs. This indicates that a change in mode of operation has occurred and the current conversion is therefore invalid.
- The MCU is reset.

When a conversion is aborted, the contents of the data registers, Rn, are not altered. The data registers continue to be the values transferred after the completion of the last successful conversion. If the conversion was aborted by a reset, RA and Rn return to their reset states.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

36.5.4.4 Power control

The ADC module remains in its Idle state until a conversion is initiated. The Idle state implies that ADC conversion routine is held in reset.

36.5.4.5 Sample time and total conversion time

The total conversion time depends upon:

- The sample time as determined by CFG2[SMPLTS]
- The MCU bus frequency
- The conversion mode, as determined by CFG1[MODE]
- The frequency of the conversion clock, that is, f_{ADCK} .

After the module becomes active, sampling of the input begins.

- 1. CFG2[SMPLTS] selects between sample times based on the conversion mode that is selected.
- 2. When sampling is completed, the converter is isolated from the input channel and a successive approximation algorithm is applied to determine the digital value of the analog signal.
- 3. The result of the conversion is transferred to Rn upon completion of the conversion algorithm.

The maximum total conversion time is determined by the clock source chosen and the divide ratio selected. The clock source is selectable by CFG1[ADICLK], and the divide ratio is specified by CFG1[ADIV]. To calculate total conversion time the following formula is applied:

ADC TOTAL CONVERSION TIME = Sample Phase Time (set by SMPLTS+1) + Hold Phase (1 ADC Cycle) + Compare Phase Time (8-bit Mode=20 ADC Cycles, 10-bit Mode=24 ADC Cycles, 12-bit Mode=28 ADC Cycles) + Single or First continuous time adder (5 ADC cycles + 5 bus clock cycles)

36.5.4.6 Hardware average function

The hardware average function can be enabled by setting SC3[AVGE]=1 to perform a hardware average of multiple conversions. The number of conversions is determined by the AVGS[1:0] bits, which can select 4, 8, 16, or 32 conversions to be averaged. While the hardware average function is in progress, SC2[ADACT] will be set.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

769

After the selected input is sampled and converted, the result is placed in an accumulator from which an average is calculated after the selected number of conversions have been completed. When hardware averaging is selected, the completion of a single conversion will not set SC1n[COCO].

If the compare function is either disabled or evaluates true, after the selected number of conversions are completed, the average conversion result is transferred into the data result registers, Rn, and SC1n[COCO] is set. An ADC interrupt is generated upon the setting of SC1n[COCO] if the respective ADC interrupt is enabled, that is, SC1n[AIEN]=1.

Note

The hardware average function can perform conversions on a channel while the MCU is in Wait or Normal Stop mode. The ADC interrupt wakes the MCU when the hardware average is completed if SC1n[AIEN] is set.

36.5.5 Automatic compare function

The compare function can be configured to check whether the result is less than or greater-than-or-equal-to a single compare value, or, if the result falls within or outside a range determined by two compare values.

The compare mode is determined by SC2[ACFGT], SC2[ACREN], and the values in the Compare Value registers (CV1 and CV2). After the input is sampled and converted, the compare values in CV1 and CV2 are used as described in the following table. There are six Compare modes as shown in the following table.

SC2[ACFGT]	SC2[ACREN]	CV1 relative to CV2	Function	Compare mode description
0	0	_	Less than threshold	Compare true if the result is less than the CV1 registers.
1	0	_	Greater than or equal to threshold	Compare true if the result is greater than or equal to CV1 registers.
0	1	Less than or equal	Outside range, not inclusive	Compare true if the result is less than CV1 Or the result is greater than CV2.
0	1	Greater than	Inside range, not inclusive	Compare true if the result is less than CV1 And the result is greater than CV2.
1	1	Less than or equal	Inside range, inclusive	Compare true if the result is greater than or equal to CV1 And the result is less than or equal to CV2.

Table 36-7. Compare modes

Table continues on the next page...

Table 36-7. Compare modes (continued)

SC2[ACFGT]	SC2[ACREN]	CV1 relative to CV2	Function	Compare mode description
1	1	Greater than	Outside range, inclusive	Compare true if the result is greater than or equal to CV1 Or the result is less than or equal to CV2.

With SC2[ACREN] =1, and if the value of CV1 is less than or equal to the value of CV2, then setting SC2[ACFGT] will select a trigger-if-inside-compare-range inclusive-of-endpoints function. Clearing SC2[ACFGT] will select a trigger-if-outside-compare-range, not-inclusive-of-endpoints function.

If CV1 is greater than CV2, setting SC2[ACFGT] will select a trigger-if-outside-compare-range, inclusive-of-endpoints function. Clearing SC2[ACFGT] will select a trigger-if-inside-compare-range, not-inclusive-of-endpoints function.

If the condition selected evaluates true, SC1n[COCO] is set.

Upon completion of a conversion while the compare function is enabled, if the compare condition is not true, SC1n[COCO] is not set and the conversion result data will not be transferred to the result register, Rn. If the hardware averaging function is enabled, the compare function compares the averaged result to the compare values. The same compare function definitions apply. An ADC interrupt is generated when SC1n[COCO] is set and the respective ADC interrupt is enabled, that is, SC1n[AIEN]=1.

Note

The compare function can monitor the voltage on a channel while the MCU is in Wait or Normal Stop mode. The ADC interrupt wakes the MCU when the compare condition is met.

36.5.6 Calibration function

The ADC is equipped with a calibration mechanism to provide high accuracy as specified in the data sheet. It is mandatory to calibrate the ADC after power up or reset. Not doing this can result in ADC conversion results with lower than specified accuracy.

In order to calibrate the ADC correctly, the following has to be done:

- On startup, wait until the reference voltage (VREFH) has stabilized.
- ADC has to be recalibrated after each system reset.
- Calibrate only one ADC instance at a time. So, when calibrating instance ADC0, the instances ADC1, ADC2, etc. are required to be idle.
- Set ADCK (ADC clock) to half the maximum specified frequency.

- Before starting calibration, the calibration registers (CLPS, CLP3, CLP2, CLP1, CLP0, CLPX, and CLP9) must be cleared by writing 0x0 into them.
- Start ADC calibration by writing ADC_SC3 register with: CAL=1, AVGE=1, AVGS=11.
- Wait for calibration to finish. This will be indicated by conversion complete flag (COCO in ADC_SC1n).
- Now you can run ADC conversions with high accuracy in your application. Please make sure to reconfigure the ADCK clock speed and reconfigure AVGE and AVGS to your desired settings. (Maximum clock speed and no use of hardware averaging is possible.)

The total calibration conversion time is: 12 * (# of AVERAGE * [Sample time (sample +1) + 1 cycle for hold + 34 cycles for compare phase]) + 1st conversion synchronization (~5 ADC cycles + 5 IPG clocks).

For high accuracy of the ADC (as specified in data sheet) on your application board (PCB), the following requirements should be met:

- Bypass caps between VREFH and VREFL. Suggested cap sizes: 1 nF, 100 nF, 10 μF.
- Place caps on PCB as close as possible to the device pins VREFH and VREFL.
- Bypass caps between VDDA and VSSA. Suggested cap sizes: 1 nF, 100 nF, 10 μF.
- Place caps on PCB as close as possible to the device pins VDDA and VSSA.
- Routing of VDDA, VSSA, VREFH, and VREFL on PCB:
 - Low impedance between the bypass caps and the MCU pins.
 - Keep routing distant from noisy signal routes like switching I/Os.

36.5.7 User-defined offset function

OFS is a two's-complement, left-justified register that contains the calibration-generated offset error correction value.

The value in OFS is subtracted from the conversion and the result is transferred into the result registers, Rn. If the result is greater than the maximum or less than the minimum result value, it is forced to the appropriate limit for the current mode of operation.

The formatting of OFS is different from the data result register, Rn, to preserve the resolution of the calibration value regardless of the conversion mode selected. Lower order bits are ignored in lower resolution modes. For example, in 8-bit single-ended mode, OFS[14:7] are subtracted from D[7:0]; OFS[15] indicates the sign (negative numbers are effectively added to the result) and OFS[6:0] are ignored.

Functional description

OFS is automatically set according to calibration requirements after the self-calibration sequence is done, that is, SC3[CAL] is cleared. You can write to OFS to override the calibration result if desired. If you write an OFS value that is different from the calibration value, the ADC error specifications may not be met. You should store the value generated by the calibration function in memory before overwriting with a user-specified value.

Note

There is an effective limit to the values of offset that you can set. If the magnitude of the offset is too high, the results of the conversions will cap off at the limits.

You can use the offset calibration function to remove application offsets or DC bias values. USR_OFS may be written with a number in two's-complement format and this offset will be subtracted from the result or hardware averaged value. To add an offset, store the negative offset in two's-complement format and the effect will be an addition. An offset correction that results in an out-of-range value will be forced to the minimum or maximum value. The minimum value for single-ended conversions is 0x0000.

36.5.8 MCU wait mode operation

Wait mode is a lower-power consumption Standby mode from which recovery is fast because the clock sources remain active.

If a conversion is in progress when the MCU enters Wait mode, it continues until completion. Conversions can be initiated while the MCU is in Wait mode by means of the hardware trigger or if continuous conversions are enabled.

The Alternate Clock sources are available as conversion clock sources while in Wait mode. The use of ALTCLK as the conversion clock source in Wait is dependent on the definition of ALTCLK for this MCU. See the Chip Configuration information on ALTCLK specific to this MCU.

If the compare and hardware averaging functions are disabled, a conversion complete event sets SC1n[COCO] and generates an ADC interrupt to wake the MCU from Wait mode if the respective ADC interrupt is enabled, that is, when SC1n[AIEN]=1. If the hardware averaging function is enabled, SC1n[COCO] will set, and generate an interrupt if enabled, when the selected number of conversions are completed. If the compare function is enabled, SC1n[COCO] will set, and generate an interrupt if enabled, only if the compare conditions are met. If a single conversion is selected and the compare trigger is not met, the ADC will return to its idle state and cannot wake the MCU from Wait mode unless a new conversion is initiated by the hardware trigger.

36.5.9 MCU Normal Stop mode operation

Stop mode is a low-power consumption Standby mode during which most or all clock sources on the MCU are disabled.

36.5.9.1 Normal Stop mode with Alternate clock sources enabled

If Alternate clock source selected for the conversion clock is enabled, the ADC continues operation during Normal Stop mode. See the chip-specific ADC information for configuration information for this device.

If a conversion is in progress when the MCU enters Normal Stop mode, it continues until completion. Conversions can be initiated while the MCU is in Normal Stop mode by means of the hardware trigger or if continuous conversions are enabled.

If the compare and hardware averaging functions are disabled, a conversion complete event sets SC1n[COCO] and generates an ADC interrupt to wake the MCU from Normal Stop mode if the respective ADC interrupt is enabled, that is, when SC1n[AIEN]=1. The result register, Rn, will contain the data from the first completed conversion that occurred during Normal Stop mode. If the hardware averaging function is enabled, SC1n[COCO] will set, and generate an interrupt if enabled, when the selected number of conversions are completed. If the compare function is enabled, SC1n[COCO] will set, and generate an interrupt if enabled, only if the compare conditions are met. If a single conversion is selected and the compare is not true, the ADC will return to its idle state and cannot wake the MCU from Normal Stop mode unless a new conversion is initiated by another hardware trigger.

36.6 Usage Guide

36.6.1 ADC module initialization sequence

Before the ADC module can be used to complete conversions, an initialization procedure must be performed. A typical sequence is as below:

- 1. Calibrate the ADC by following the calibration instructions in Calibration function.
- 2. Update CFG to select the input clock source and the divide ratio used to generate ADCK.
- 3. Update SC2 to select the conversion trigger, hardware or software, and compare function options, if enabled.

Usage Guide

- 4. Update SC3 to select whether conversions will be continuous or completed only once (ADCO) and whether to perform hardware averaging.
- 5. Update SC1:SC1*n* registers to enable or disable conversion complete interrupts.

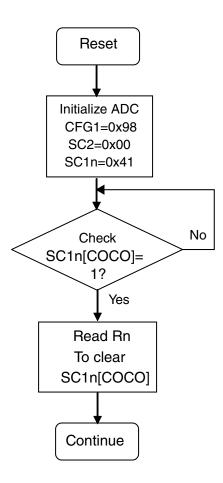
Also, select the input channel which can be used to perform conversions.

36.6.2 Pseudo-code example

In this example, the ADC module is set up with interrupts enabled to perform a single 10-bit conversion at low-power with a long sample time on input channel 1, where ADCK is derived from the bus clock divided by 1.

```
ADC CFG1 = ADC CFG1 ADLPC MASK
ADC CFG1 ADLSMP MASK | ADC CFG1 MODE (0x10);
// Bit 7 ADLPC 1 Configures for low power, lowers maximum clock speed.
// Bit 6:5 ADIV 00 Sets the ADCK to the input clock ÷ 1.
// Bit 4 ADLSMP 1 Configures for long sample time.
// Bit 3:2 MODE 10 Selects the single-ended 10-bit conversion.
// Bit 1:0 ADICLK 00 Selects the bus clock.
ADC_SC2 = 0x00;
// Bit 7 ADACT 0 Flag indicates if a conversion is in progress.
// Bit 6 ADTRG 0 Software trigger selected.
// Bit 5 ACFE 0 Compare function disabled.
// Bit 4 ACFGT 0 Not used in this example.
// Bit 3 ACREN 0 Compare range disabled.
// Bit 2 DMAEN 0 DMA request disabled.
// Bit 1:0 REFSEL 00 Selects default voltage reference pin pair (External pins VREFH
V_{REFL} ).
ADC SC1A = ADC SC1 AIEN MASK | ADC SC1 ADCH(0x1);
// Bit 7 COCO 0 Read-only flag which is set when a conversion completes.
// Bit 6 AIEN 1 Conversion complete interrupt enabled.
// Bit 4:0 ADCH 00001 Input channel 1 selected as ADC input channel.
ADC RA = 0xxx
// Holds results of conversion.
ADC CV = 0xxx
// Holds compare value when compare function enabled.
```

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018



36.6.3 Calibration

The ADC contains a self-calibration function that is required to achieve the specified accuracy. Calibration must be run, or valid calibration values written, after any reset and before a conversion is initiated. Not doing this can result in ADC conversion results with lower than specified accuracy.

In order to calibrate ADC correctly the following steps have to be done:

- On startup, wait until reference voltage (VREFH/VREFL) has stabilized, use 3 bypass capacitance in the range: 1 µF, 100 nF and 1 nF.
- Calibrate only one ADC instance at a time, no parallel calibration of ADCs because they will disturb each other.
- Set ADCK (ADC clock) to half the maximum specified frequency, e.g. 25 MHz.
- Start ADC calibration by writing ADC_SC3 register with: CAL=1, AVGE=1, AVGS=11.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Usage Guide

- Wait for calibration to finish. This will be indicated by conversion complete flag (COCO in ADC_SC1A).
- Run ADC conversions with high accuracy in your application. Make sure to reconfigure ADCK clock speed and to re-configure AVGE and AVGS to the desired settings.

For more detailed information about calibration guidelines, refer to the application note AN5314: ADC Calibration on Kinetis E+ Microcontrollers.

NOTE

In the OFS, CLPX and CLP9 registers, the calibration values are signed numbers (in 2's complement format).

36.6.4 Application hints

The ADC has been designed to be integrated into a microcontroller for use in embedded control applications requiring an ADC. For guidance on selecting optimum external component values and converter parameters, refer to the application note AN5250: How to Increase the Analog-to-Digital Converter Accuracy in an Application.

36.6.5 DMA Support on ADC

Applications may require continuous sampling of the ADC (4K samples/sec) that may have considerable load on the CPU. Though using PDB to trigger ADC may reduce some CPU load, the ADC supports DMA request functionality for higher performance when the ADC is sampled at a very high rate or cases where PDB is bypassed. The ADC can trigger the DMA (via DMA req) on conversion completion.

For most cases, the DMA request can be directly triggered from ADC conversion completion. The device also support another way to trigger DMA via TRGMUX module. The TRGMUX will provide user a more flexible DMA triggering scheme using software based on different application requirements, for example, the DMA can be triggered after multiple ADC conversion completion instead of every ADC conversion completion.

36.6.6 ADC low-power modes

The ADC will be available in STOP, VLPR, VLPW, and VLPS mode.

NOTE

When in VLPx mode, the ADC clock source is only limited to OSC and SIRC.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

36.6.7 ADC Trigger Concept – Use Case

FTM module support counter init trigger and channel match trigger, these triggers could be used as trigger input of PDB, PDB then be used to trigger other modules like ADC. Each ADC channel in PDB module supports up to 2 pre-triggers, which could be used as ADC hardware channel selection to precondition the ADC block prior to actual trigger. The ADC trigger is initiated after pre-trigger to trigger ADC conversion. The waveforms shown in following diagram illustrate the pre-trigger and trigger output of PDB to ADC. Every time when one PDB pre-trigger and trigger output starts an ADC conversion, an internal lock associated with the corresponding pre-trigger is activated. This lock becomes inactive when receiving COCO signal from ADC.

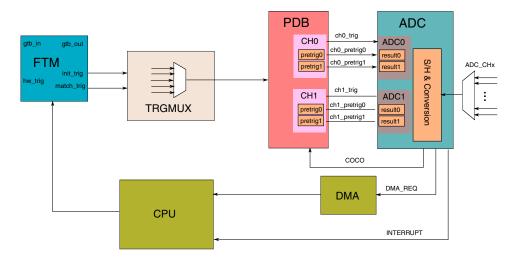


Figure 36-3. PWM Load Diagnosis – ADC Trigger Concept (block diagram)

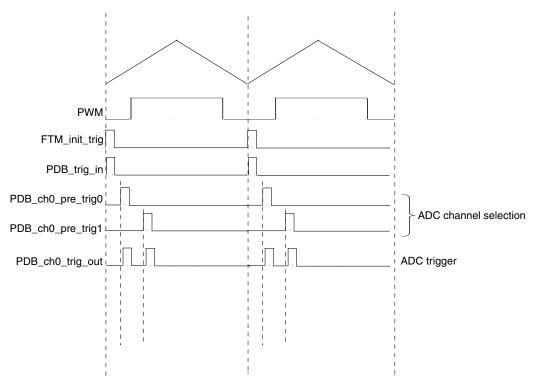


Figure 36-4. PWM Load Diagnosis – ADC Trigger Concept 1 (Timing)

ADC self-test and calibration scheme

ADC calibration needs to be initiated by setting the ADCx_SC3[CAL] bit.

The ADC contains a self-calibration function that is required to achieve the specified accuracy. Calibration must be run, or valid calibration values written, after any reset and before a conversion is initiated. Not doing this can result in ADC conversion results with lower than specified accuracy. Calibration needs to be initiated manually by setting the CAL bit. For more details, please refer to "Calibration" section.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018 778 **NXP Semiconductors**

Chapter 37 Comparator (CMP)

37.1 Chip-specific information for this module

37.1.1 Instantiation information

Number of CMP	2		
8-bit DAC sub-block	Each CMP has its own independent 8-bit DAC.1		
Analog inputs	Each CMP supports up to 6 analog inputs from external pins.		
Internal reference	Each CMP is able to convert an internal reference from the bandgap (1 V reference voltage).		
Round-robin mode	Each CMP supports the round-robin sampling scheme. ²		

^{1.} Only DAC0 supports output to pad through a buffer.

37.1.1.1 CMP input connections

The following table shows the input connections to the CMP.

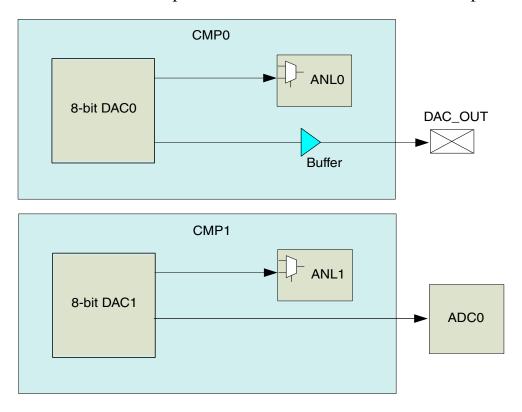
Table 37-1. CMP input connections

CMP Inputs	СМРО	CMP1
INO	ACMP0_IN0	ACMP1_IN0
IN1	ACMP0_IN1	ACMP1_IN1
IN2	ACMP0_IN2	ACMP1_IN2
IN3	ACMP0_IN3	ACMP1_IN3
IN4	ACMP0_IN4	ACMP1_IN4
IN5	ACMP0_IN5	ACMP1_IN5
IN6	Reserved	Reserved
IN7	Reserved	Reserved

^{2.} In summary, this allow the CMP to operate independently in STOP and VLPS mode, whilst being triggered periodically to sample up to 6 inputs. Only if an input changes state is a full wakeup generated.

37.1.1.2 8-bit DAC output connections

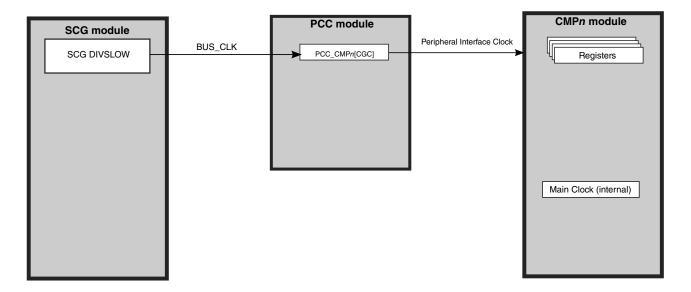
Each CMP has its built-in 8-bit DAC as reference. The following figure shows the DAC interconnectivity with CMP, ADC and output buffer. 8-bit DAC0 supports output to pad through a buffer. 8-bit DAC1 output could be used as ADC0 reference input.



37.1.2 CMP Clocking Information

The CMP clocking input is as below.

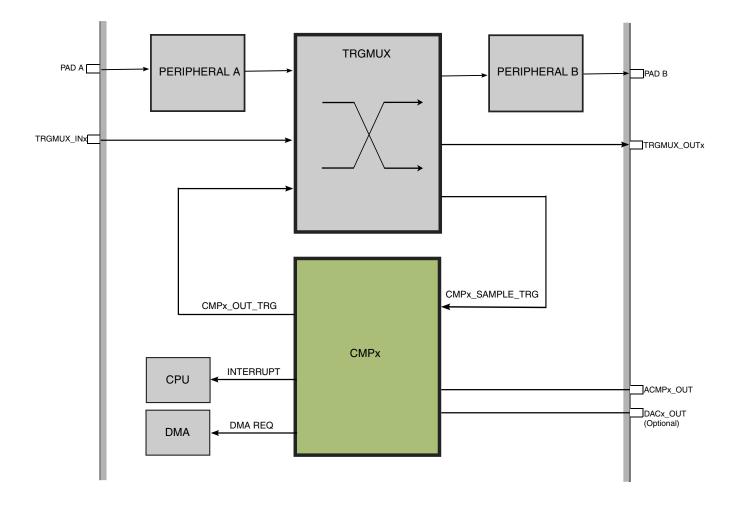
Peripheral Clocking - CMP



37.1.3 Inter-connectivity Information

The CMP inter-connectivity is shown in following diagram.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018



37.1.4 Application-related Information

37.1.4.1 CMP external references

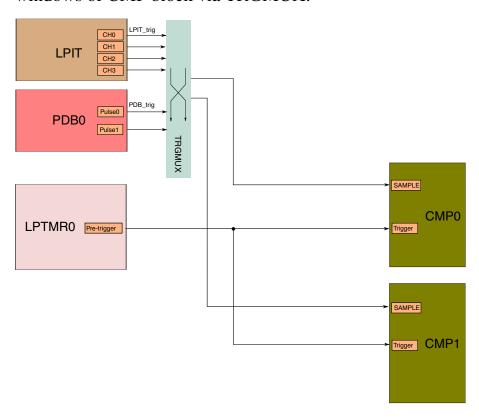
The CMP could get external reference through the tightly integrated 8-bit DAC sub-block. The 8-bit DAC sub-block supports selection of two references. For this device, the references are connected as follows:

- \bullet VDDA -- connected to V_{in2} of CMP
- \bullet PMC bandgap buffer out (1V reference voltage) -- connected to V_{in1} of CMP

783

37.1.4.2 External window/sample input

PDB and LPIT could be used to generate pulse output which can be used as sampling windows of CMP block via TRGMUX.



37.1.4.3 CMP trigger mode

The CMP and 8-bit DAC sub-block supports trigger mode operation when the chip is in STOP or VLPS mode. When trigger mode is enabled, the trigger source will provide a low power clock and the triggers to the CMP. The trigger event will initiate a compare sequence that must first enable the CMP and DAC prior to performing a CMP operation and capturing the output.

In this device, control for this two-staged sequencing is provided from, for example, LPTMR. The LPTMR provides a single trigger output to all implemented comparators. Through configuration of the CMPx_C2[RRE] bits the trigger can be used to trigger a single comparator or multiple comparators concurrently. The LPTMR only offers single wire trigger to CMP. And the configuration must be done by LPTMR itself (round robin) before entering low power mode.

37.2 Introduction

The comparator (CMP) module provides a circuit for comparing two analog input voltages. The comparator circuit is designed to operate across the full range of the supply voltage, known as rail-to-rail operation.

The Analog MUX (ANMUX) provides a circuit for selecting an analog input signal from eight channels. One signal is provided by the 8-bit digital-to-analog converter (DAC). The mux circuit is designed to operate across the full range of the supply voltage.

The DAC is a 256-tap resistor ladder network that provides a selectable voltage reference for applications requiring a voltage reference. The 256-tap resistor ladder network divides the supply reference V_{in} into 256 voltage levels. A 8-bit digital signal input selects the output voltage level, which varies from V_{in} to $V_{in}/256$. V_{in} can be selected from two voltage sources, V_{in1} and V_{in2} . The DAC from a comparator is available as an on-chip internal signal only and is not available externally to a pin.

37.3 Features

The following subsections list the features of the CMP, the DAC, and the ANMUX.

37.3.1 CMP features

The CMP has the following features:

- Operational over the entire supply range
- Inputs may range from rail to rail
- Programmable hysteresis control
- Selectable interrupt on rising-edge, falling-edge, or both rising or falling edges of the comparator output
- Selectable inversion on comparator output
- Capability to produce a wide range of outputs such as:
 - Sampled
 - Windowed, which is ideal for certain PWM zero-crossing-detection applications
 - Digitally filtered:

- Filter can be bypassed
- Can be clocked via external SAMPLE signal or scaled bus clock
- External hysteresis can be used at the same time that the output filter is used for internal functions
- Two software selectable performance levels:
 - Shorter propagation delay at the expense of higher power
 - Low power, with longer propagation delay
- DMA transfer support
 - A comparison event can be selected to trigger a DMA transfer
- Functional in all power modes available on this MCU
- The window and filter functions are not available in STOP modes
- The comparator can be triggered by other peripherals to work for only a small fraction of the time

37.3.2 8-bit DAC key features

The DAC has the following features:

- 8-bit resolution
- Selectable supply reference source
- Power Down mode to conserve power when not in use
- Option to route the output to internal comparator input

37.3.3 ANMUX key features

The ANMUX has the following features:

- Two 8-to-1 channel MUXes
- Operational over the entire supply range

37.4 CMP, DAC, and ANMUX diagram

The following figure shows the block diagram for the High-Speed Comparator, DAC, and ANMUX modules.

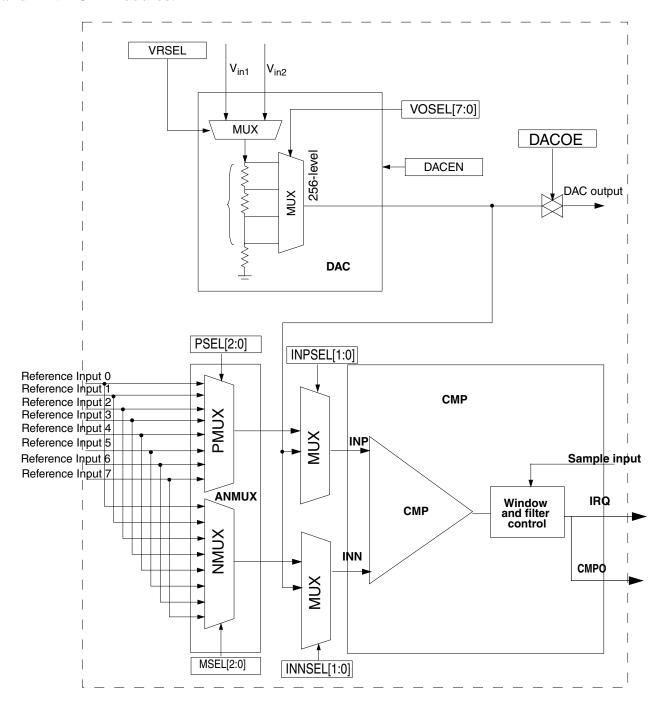


Figure 37-1. CMP high level diagram

37.5 CMP block diagram

The following figure shows the block diagram for the CMP module.

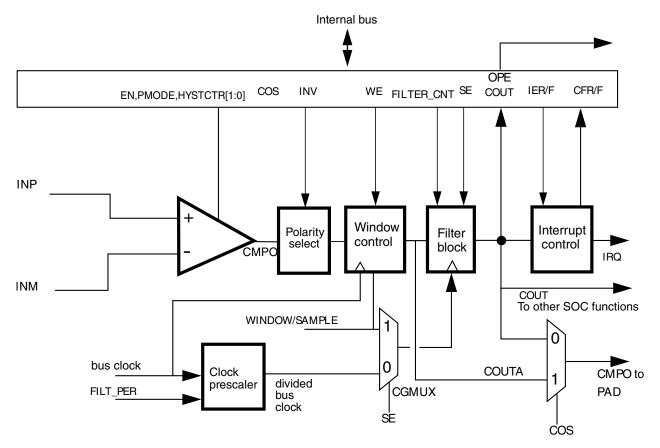


Figure 37-2. Comparator module block diagram

In the CMP block diagram:

- The Window Control block is bypassed when C0[WE] = 0.
- If C0[WE] = 1, the comparator output is sampled on every bus clock when WINDOW=1 to generate COUTA. Sampling does NOT occur when WINDOW = 0.
- The Filter block is bypassed when not in use.

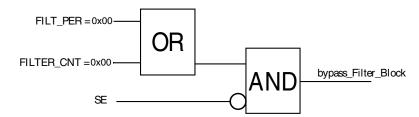


Figure 37-3. Filter block bypass logic

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

CMP pin descriptions

- The Filter block acts as a simple sampler if the filter is bypassed and C0[FILTER_CNT] is set to 0x01.
- The Filter block filters based on multiple samples when the filter is bypassed and C0[FILTER_CNT] is set greater than 0x01.
 - If C0[SE] = 1, the external SAMPLE input is used as the sampling clock.
 - IF C0[SE] = 0, the divided bus clock is used as the sampling clock.
- If enabled, the Filter block will incur up to one bus clock additional latency penalty on COUT due to the fact that COUT, which crosses clock domain boundaries, must be resynchronized to the bus clock.
- C0[WE] and C0[SE] are mutually exclusive.
- If enabled, the filter clock and the sample period must be at least 4 times slower than the system clock to the comparator.

37.6 CMP pin descriptions

This section provides the comparator pin descriptions. The external inputs IN[7:0] are muxed by CMP_C1[PSEL] and CMP_C1[MSEL] beforehand and multiplexed output will then go to the second stage of multiplex with the input of 8-bit DAC and other two internal reserved test signals, determined by CMP_C1[INPSEL] and CMP_C1[INNSEL]. The output of the second multiplex will finally go to the positive and negative ports of the comparator respectively.

Table 37-2. CMP signal descriptions

Signal	Description	1/0
IN[7:0]	Analog voltage inputs	I

NOTE

If comparing one input channel with the DAC output, and if there is injection or over-voltage in the input channels, the DAC output may be corrupted. For such case, the software workaround is to configure the DAC side SEL[2:0] same as the non-DAC side, i.e. configuration of MSEL and PSEL register bits must be the same.

789

37.6.1 External pins

The CMP has two analog inputs: INP and INM. Each of these pins can accept an input voltage that varies across the full operating range of the MCU. If the module is not enabled, each pin can be used as a digital input or output. Consult the specific MCU documentation to determine what functions are shared with these analog inputs.

The user can select either filtered or unfiltered comparator outputs for use on an external I/O pad.

37.7 CMP functional modes

There are three main sub-blocks to the CMP module:

- The comparator itself
- The window function
- The filter function

The filter, C0[FILTER_CNT], can be clocked from an internal or external clock source. The filter is programmable with respect to the number of samples that must agree before a change in the output is registered. In the simplest case, only one sample must agree. In this case, the filter acts as a simple sampler.

The external sample input is enabled using C0[SE]. When set, the output of the comparator is sampled only on rising edges of the sample input.

The "windowing mode" is enabled by setting C0[WE]. When set, the comparator output is sampled only when WINDOW=1. This feature can be used to ignore the comparator output during time periods in which the input voltages are not valid. This is especially useful when implementing zero-crossing-detection for certain PWM applications.

The comparator filter and sampling features can be combined as shown in the following table. Individual modes are discussed below.

C0[FILTER_CN Operation Mode # C0[EN] C0[WE] C0[SE] C0[FPR] T] Χ 0 Х Х Χ 1 **Disabled** See the Disabled mode (# 1). 0 Х 2A 1 0 0x00 **Continuous Mode**

Table 37-3. Comparator sample/filter controls

Table continues on the next page...

Table 37-3. Comparator sample/filter controls (continued)

Mode #	C0[EN]	C0[WE]	C0[SE]	C0[FILTER_CN T]	C0[FPR]	Operation
2B	1	0	0	Х	0x00	See the Continuous mode (#s 2A & 2B).
3A	1	0	1	0x01	Х	Sampled, Non-Filtered mode
3B	1	0	0	0x01	> 0x00	See the Sampled, Non-Filtered mode (#s 3A & 3B).
4A	1	0	1	> 0x01	Х	Sampled, Filtered mode
4B	1	0	0	> 0x01	> 0x04	See the Sampled, Filtered mode (#s 4A & 4B).
5A	1	1	0	0x00	X	Windowed mode
5B	1	1	0	X	0x00	Comparator output is sampled on every rising bus clock edge when SAMPLE=1 to generate COUTA.
						See the Windowed mode (#s 5A & 5B).
6	1	1	0	0x01	0x01-0xFF	Windowed/Resampled mode
						Comparator output is sampled on every rising bus clock edge when SAMPLE=1 to generate COUTA, which is then resampled on an interval determined by C0[FPR] to generate COUT.
						See the Windowed/Resampled mode (# 6).
7	1	1	0	> 0x01	0x01-0xFF	Windowed/Filtered mode
						Comparator output is sampled on every rising bus clock edge when SAMPLE=1 to generate COUTA, which is then resampled and filtered to generate COUT.
						See the Windowed/Filtered mode (#7).
	All other combinations of C0[EN], C0[WE], C0[SE], C0[FILTER_CNT], and C0[FPR] are illegal.					

For cases where a comparator is used to drive a fault input, for example, for a motor-control module such as FTM, it must be configured to operate in Continuous mode so that an external fault can immediately pass through the comparator to the target fault circuitry.

Note

Filtering and sampling settings must be changed only after setting C0[SE]=0, C0[FPR] =0 and C0[FILTER_CNT]=0x00. This resets the filter to a known state.

37.7.1 Disabled mode (# 1)

In Disabled mode, the analog comparator is non-functional and consumes no power. CMPO is 0 in this mode.

37.7.2 Continuous mode (#s 2A & 2B)

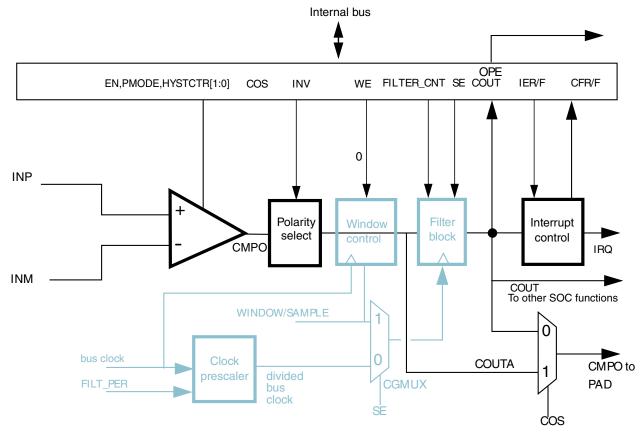


Figure 37-4. Comparator operation in Continuous mode

NOTE

See the chip configuration section for the source of sample/ window input.

The analog comparator block is powered and active. CMPO may be optionally inverted, but is not subject to external sampling or filtering. Both window control and filter blocks are completely bypassed (as the grey-colored parts in the figure). C0[COUT] is updated continuously. The path from comparator input pins to output pin is operating in combinational unclocked mode. COUT and COUTA are identical.

For control configurations that result in disabling the filter block, see Figure 37-3.

Internal bus WE FILTER_CNT SE COUT IER/F CFR/F EN,PMODE,HYSTCTR[1:0] COS INV 0 0x01 INP -Polarity Filter Window Interrupt select block control control IRQ INM To other SOC functions WINDOW/SAMPLE 0 bus clock Clock 0 **COUTA** CMPO to divided CGMUX FILT_PER PAD

Sampled, Non-Filtered mode (#s 3A & 3B) 37.7.3

Figure 37-5. Sampled, Non-Filtered (# 3A): sampling point externally driven

SE=1

clock

In Sampled, Non-Filtered mode, the analog comparator block is powered and active. The path from analog inputs to COUTA is combinational unclocked. Windowing control is completely bypassed. COUTA is sampled whenever a rising edge is detected on the filter block clock input.

The only difference in operation between Sampled, Non-Filtered (# 3A) and Sampled, Non-Filtered (# 3B) is in how the clock to the filter block is derived. In #3A, the clock to filter block is externally derived while in #3B, the clock to filter block is internally derived.

The comparator filter has no other function than sample/hold of the comparator output in this mode (# 3B).

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018 792 NXP Semiconductors

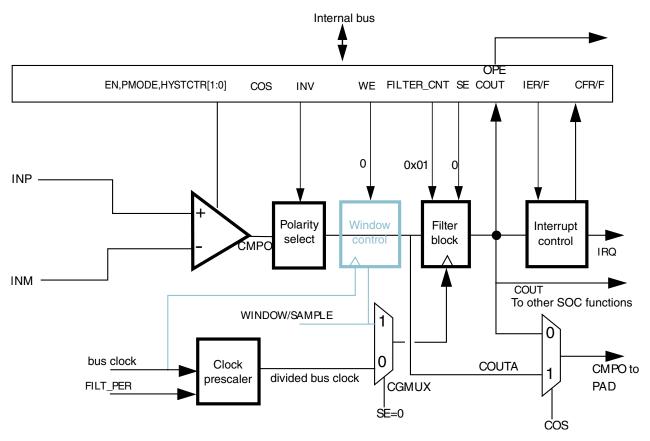


Figure 37-6. Sampled, Non-Filtered (# 3B): sampling interval internally derived

The following figure illustrates comparator operation in this mode, assuming the polarity select is set to non-inverting state.

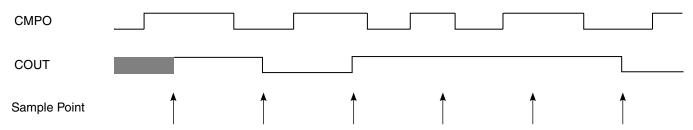


Figure 37-7. Sampled, Non-Filtered Mode Timing Diagram

37.7.4 Sampled, Filtered mode (#s 4A & 4B)

In Sampled, Filtered mode, the analog comparator block is powered and active. The path from analog inputs to COUTA is combinational unclocked. Windowing control is completely bypassed. COUTA is sampled whenever a rising edge is detected on the filter block clock input.

CMP functional modes

The only difference in operation between Sampled, Non-Filtered (# 3A) and Sampled, Filtered (# 4A) is that, now, C0[FILTER_CNT]>1, which activates filter operation.

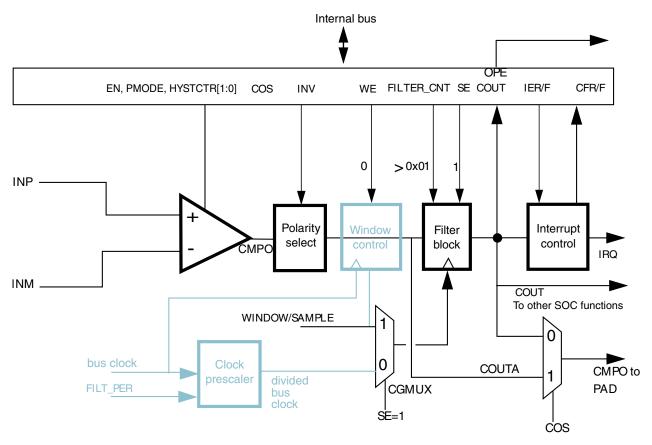


Figure 37-8. Sampled, Filtered (# 4A): sampling point externally driven

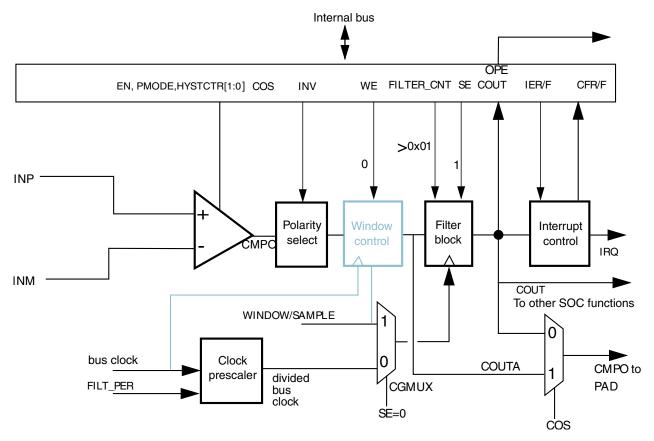


Figure 37-9. Sampled, Filtered (# 4B): sampling point internally derived

The only difference in operation between Sampled, Non-Filtered (# 3B) and Sampled, Filtered (# 4B) is that now, C0[FILTER_CNT]>1, which activates filter operation.

37.7.5 Windowed mode (#s 5A & 5B)

The following figure illustrates comparator operation in the Windowed mode, ignoring latency of the analog comparator, polarity select, and window control block. It also assumes that the polarity select is set to non-inverting state.

NOTE

The analog comparator output is passed to COUTA only when the WINDOW signal is high.

In actual operation, COUTA may lag the analog inputs by up to one bus clock cycle plus the combinational path delay through the comparator and polarity select logic.

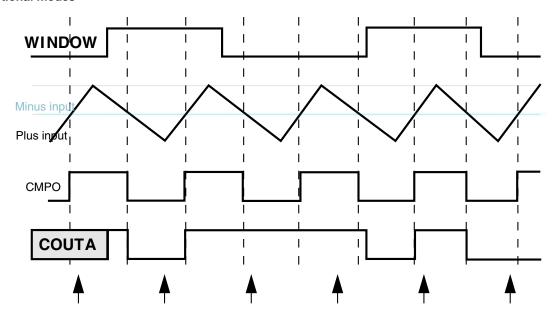


Figure 37-10. Windowed mode timing diagram

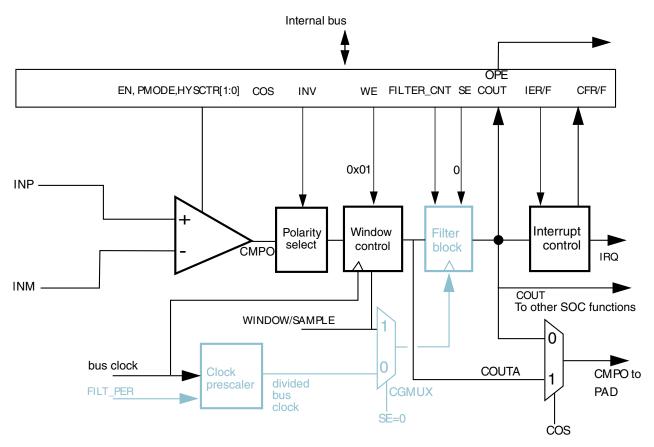


Figure 37-11. Windowed mode

For control configurations which result in disabling the filter block, see Figure 37-3.

When any windowed mode is active, COUTA is clocked by the bus clock whenever WINDOW = 1. The last latched value is held when WINDOW = 0.

NOTE

The sample input must be high for ≥ 2.5 CMP bus clock cycles to ensure no sampling event is missed.

37.7.6 Windowed/Resampled mode (# 6)

The following figure uses the same input stimulus shown in Figure 37-10, and adds resampling of COUTA to generate COUT. Samples are taken at the time points indicated by the arrows in the figure. Again, prop delays and latency are ignored for the sake of clarity.

This example was generated solely to demonstrate operation of the comparator in windowed/resampled mode, and does not reflect any specific application. Depending upon the sampling rate and window placement, COUT may not see zero-crossing events detected by the analog comparator. Sampling period and/or window placement must be carefully considered for a given application.

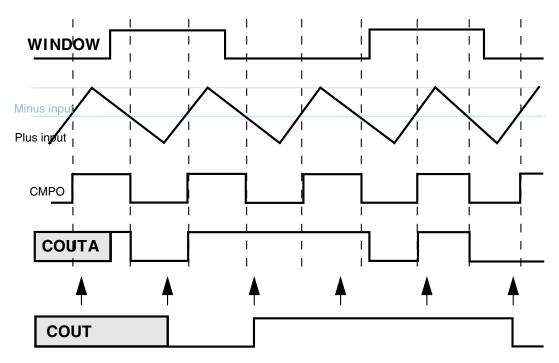


Figure 37-12. Windowed/resampled mode operation

This mode of operation results in an unfiltered string of comparator samples where the interval between the samples is determined by FPR[FILT_PER] and the bus clock rate. Configuration for this mode is virtually identical to that for the Windowed/Filtered Mode shown in the next section. The only difference is that the value of C0[FILTER_CNT] must be 1.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

NOTE

The sample input must be high for ≥ 2.5 CMP bus clock cycles to ensure no sampling event is missed.

37.7.7 Windowed/Filtered mode (#7)

This is the most complex mode of operation for the comparator block, as it uses both windowing and filtering features. It also has the highest latency of any of the modes. This can be approximated: up to 1 bus clock synchronization in the window function + $[(C0[FILTER_CNT] \times C0[FPR]) + 1] \times bus clock for the filter function.$

When any windowed mode is active, COUTA is clocked by the bus clock whenever WINDOW = 1. The last latched value is held when WINDOW = 0.

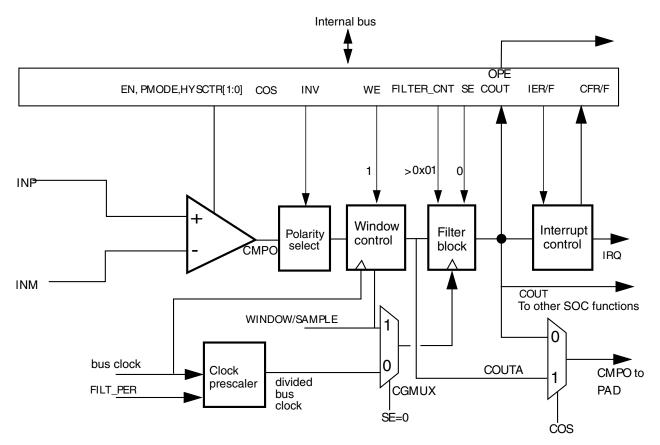


Figure 37-13. Windowed/Filtered mode

The following figure shows the operation timing for this mode, considering uncertainty is introduced by the internal synchronization for the filter block.

NXP Semiconductors

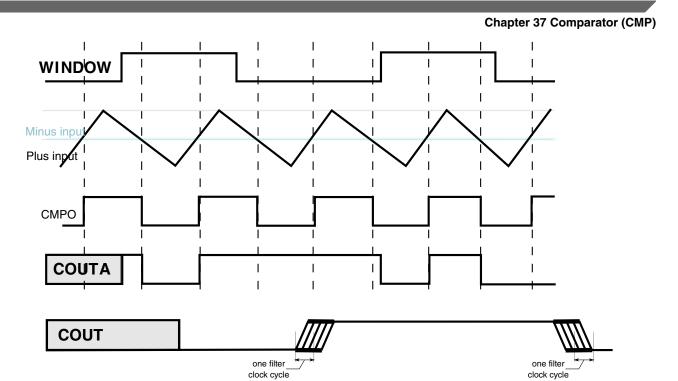


Figure 37-14. Windowed/Filtered mode operation

37.8 Memory map/register definitions

CMP memory map

Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page	
4007_3000	CMP Control Register 0 (CMP0_C0)	32	R/W	0000_0000h	37.8.1/799	
4007_3004	CMP Control Register 1 (CMP0_C1) 32 R/W 0000_0000h					
4007_3008	CMP Control Register 2 (CMP0_C2) 32 R/W 0000_0000h					
4007_4000	CMP Control Register 0 (CMP1_C0)	32	R/W	0000_0000h	37.8.1/799	
4007_4004	CMP Control Register 1 (CMP1_C1) 32 R/W 0000_0000h					
4007_4008	CMP Control Register 2 (CMP1_C2)	32	R/W	0000_0000h	37.8.3/806	

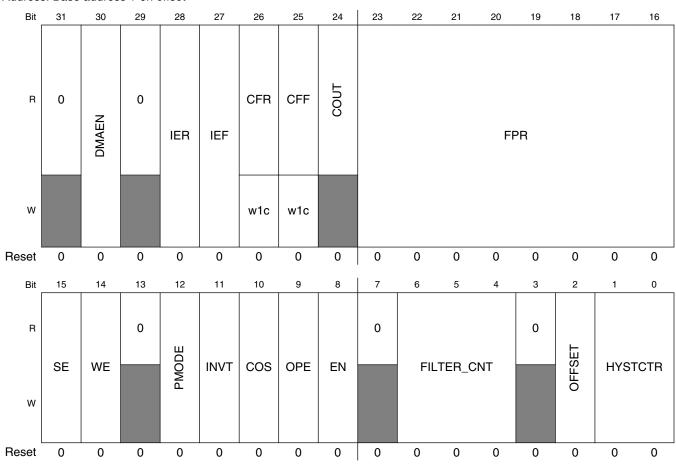
37.8.1 CMP Control Register 0 (CMPx_C0)

Access:

- Supervisor read/write
- User read/write

Memory map/register definitions

Address: Base address + 0h offset



CMPx_C0 field descriptions

Field	Description
31 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
30 DMAEN	DMA Enable Enables the DMA transfer triggered from the CMP module. When this field is set, a DMA request is asserted when CFR or CFF is set. 0 DMA is disabled. 1 DMA is enabled.
29 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
28 IER	Comparator Interrupt Enable Rising Enables the CFR interrupt from the CMP. When this field is set, an interrupt will be asserted when CFR is set. 0 Interrupt is disabled. 1 Interrupt is enabled.
27 IEF	Comparator Interrupt Enable Falling

Table continues on the next page...

CMPx_C0 field descriptions (continued)

Field	Description
	Enables the CFF interrupt from the CMP. When this field is set, an interrupt will be asserted when CFF is set.
	0 Interrupt is disabled.
	1 Interrupt is enabled.
26 CFR	Analog Comparator Flag Rising
	Detects a rising-edge on COUT, when set, during normal operation. CFR is cleared by writing 1 to it. During Stop modes, CFR is level sensitive
	0 A rising edge has not been detected on COUT.
	1 A rising edge on COUT has occurred.
25 CFF	Analog Comparator Flag Falling
	Detects a falling-edge on COUT, when set, during normal operation. CFF is cleared by writing 1 to it. During Stop modes, CFF is level sensitive .
	0 A falling edge has not been detected on COUT.
	1 A falling edge on COUT has occurred.
24 COUT	Analog Comparator Output
0001	Returns the current value of the Analog Comparator output, when read. The field is reset to 0 and will read
	as C0[INVT] when the Analog Comparator module is disabled, that is, when C0[EN] = 0. Writes to this field are ignored.
23–16 FPR	Filter Sample Period
	Specifies the sampling period, in bus clock cycles, of the comparator output filter, when C0[SE] = 0. Setting FPR to 0x0 disables the filter. Filter programming and latency details are provided in the CMP functional description. This field has no effect when C0[SE] = 1. In that case, the external SAMPLE signal is used to determine the sampling period.
15 SE	Sample Enable
J. J.	At any given time, either SE or WE can be set. If a write to this register attempts to set both, then SE is set and WE is cleared. However, avoid writing ones to both bit locations because this "11" case is reserved.
	0 Sampling mode is not selected.
	1 Sampling mode is selected.
14	Windowing Enable
WE	At any given time, either SE or WE can be set. If a write to this register attempts to set both, then SE is set
	and WE is cleared. However, avoid writing ones to both bit locations because this "11" case is reserved.
	0 Windowing mode is not selected.
	1 Windowing mode is selected.
13 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
12	Power Mode Select
PMODE	0 Low Speed (LS) comparison mode is selected.
	High Speed (HS) comparison mode is selected, in VLPx mode, or Stop mode switched to Low Speed
	(LS) mode.

Table continues on the next page...

Memory map/register definitions

CMPx_C0 field descriptions (continued)

Field	Description					
11	Comparator invert					
INVT	This bit allows selecting the polarity of the analog comparator function. It is also driven to the COUT output (on both the device pin and as C0[COUT]) when C0[OPE]=0.					
	0 Does not invert the comparator output.					
	1 Inverts the comparator output.					
10 COS	Comparator Output Select					
	Set CMPO to equal COUT (filtered comparator output). Set CMPO to equal COUTA (unfiltered comparator output).					
9 OPE	Comparator Output Pin Enable					
012	The OPE bit enables the path from the comparator output to a selected pin.					
	0 When OPE is 0, the comparator output (after window/filter settings dependent on software configuration) is not available to a packaged pin.					
	When OPE is 1, and if the software has configured the comparator to own a packaged pin, the comparator is available in a packaged pin.					
8 EN	Comparator Module Enable					
EIN	The EN bit enables the Analog Comparator Module. When the module is not enabled, the analog part remains in the off state, and consumes no power.					
	0 Analog Comparator is disabled.					
	1 Analog Comparator is enabled.					
7 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.					
6–4	Filter Sample Count					
FILTER_CNT	This field specifies the number of consecutive samples that must agree prior to the comparator output filter accepting a new output state. For information regarding filter programming and latency, please see the Functional Description.					
	000 Filter is disabled. If SE = 1, then COUT is a logic zero (this is not a legal state, and is not recommended). If SE = 0, COUT = COUTA.					
	001 1 consecutive sample must agree (comparator output is simply sampled).					
	010 2 consecutive samples must agree.					
	011 3 consecutive samples must agree.					
	100 4 consecutive samples must agree.					
	101 5 consecutive samples must agree.110 6 consecutive samples must agree.					
	111 7 consecutive samples must agree.					
3	This field is reserved.					
Reserved	This read-only field is reserved and always has the value 0.					
2 OFFSET	Comparator hard block offset control. See chip data sheet to get the actual offset value with each level					

Table continues on the next page...

CMPx_C0 field descriptions (continued)

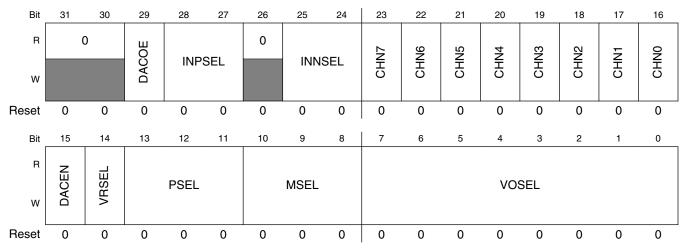
Field	Description					
	 If OFFSET = 1, then there will be no hysteresis in the case of INP crossing INN in the positive direction (or INN crossing INP in the negative direction). A Half Hysteresis value still exists for INP crossing INN in the falling direction. If OFFSET = 0, then the hysteresis selected by HYSTCTR is valid for both directions. 					
	0 The comparator hard block output has level 0 offset internally.					
	1 The comparator hard block output has level 1 offset internally.					
HYSTCTR	Comparator hard block hysteresis control. See chip data sheet to get the actual hysteresis value with eac level					
	00 The hard block output has level 0 hysteresis internally.					
	01 The hard block output has level 1 hysteresis internally.					
	10 The hard block output has level 2 hysteresis internally.					
	11 The hard block output has level 3 hysteresis internally.					

37.8.2 CMP Control Register 1 (CMPx_C1)

Access:

- Supervisor read/write
- User read/write

Address: Base address + 4h offset



CMPx_C1 field descriptions

Field	Description				
	This field is reserved. This read-only field is reserved and always has the value 0.				
29 DACOE	DAC output Enable				

Table continues on the next page...

Memory map/register definitions

CMPx_C1 field descriptions (continued)

Field	Description			
	This bit is used to enable the output of DAC to outside of this block. When this bit is set, the 8-bit DAC output will be available for other peripheral usage.			
	0 DAC output is disabled to go outside.			
	1 DAC output is enabled to go outside.			
28–27 INPSEL	Selection of the input to the positive port of the comparator			
	Determines which input is selected for the plus input of the comparator.			
	NOTE: These selections is used to select the final positive input to the comparator.			
	Note: For the round robin mode of operation, the MSEL and PSEL bitfields in CMPx_C1 register must have different values.			
	00 IN0, from the 8-bit DAC output			
	01 IN1, from the analog 8-1 mux			
	10 Reserved			
	11 Reserved			
26	This field is reserved.			
Reserved	This read-only field is reserved and always has the value 0.			
25–24 INNSEL	Selection of the input to the negative port of the comparator			
	Determines which input is selected for the plus input of the comparator.			
	NOTE: These selections is used to select the final negative input to the comparator.			
	Note: For the round robin mode of operation, the MSEL and PSEL bitfields in CMPx_C1 register must have different values.			
	00 IN0, from the 8-bit DAC output			
	01 IN1, from the analog 8-1 mux			
	10 Reserved			
	11 Reserved			
23 CHN7	Channel 7 input enable			
	Channel 7 of the input enable for the round-robin checker. If CHN7 is set, then the corresponding channel to the non-fixed mux port is enabled to check its voltage value in the round-robin mode. If the same channel is selected as the reference voltage, this bit has no effect.			
22	Channel 6 input enable			
CHN6	Channel 6 of the input enable for the round-robin checker. If CHN6 is set, then the corresponding channel to the non-fixed mux port is enabled to check its voltage value in the round-robin mode. If the same channel is selected as the reference voltage, this bit has no effect.			
21 CHN5	Channel 5 input enable			
	Channel 5 of the input enable for the round-robin checker. If CHN5 is set, then the corresponding channel to the non-fixed mux port is enabled to check its voltage value in the round-robin mode. If the same channel is selected as the reference voltage, this bit has no effect.			
20	Channel 4 input enable			
CHN4	Channel 4 of the input enable for the round-robin checker. If CHN4 is set, then the corresponding channel to the non-fixed mux port is enabled to check its voltage value in the round-robin mode. If the same			
	channel is selected as the reference voltage, this bit has no effect.			

Table continues on the next page...

CMPx_C1 field descriptions (continued)

Field	Description
19	Channel 3 input enable
CHN3	Channel 3 of the input enable for the round-robin checker. If CHN3 is set, then the corresponding channel to the non-fixed mux port is enabled to check its voltage value in the round-robin mode. If the same channel is selected as the reference voltage, this bit has no effect.
18	Channel 2 input enable
CHN2	Channel 2 of the input enable for the round-robin checker. If CHN2 is set, then the corresponding channel to the non-fixed mux port is enabled to check its voltage value in the round-robin mode. If the same channel is selected as the reference voltage, this bit has no effect.
17	Channel 1 input enable
CHN1	Channel 1 of the input enable for the round-robin checker. If CHN1 is set, then the corresponding channel to the non-fixed mux port is enabled to check its voltage value in the round-robin mode. If the same channel is selected as the reference voltage, this bit has no effect.
16 CHN0	Channel 0 input enable
CHNU	Channel 0 of the input enable for the round-robin checker. If CHN0 is set, then the corresponding channel to the non-fixed mux port is enabled to check its voltage value in the round-robin mode. If the same channel is selected as the reference voltage, this bit has no effect.
15 DACEN	DAC Enable
DACEN	This bit is used to enable the DAC. When the DAC is disabled, it is powered down to conserve power.
	0 DAC is disabled.
	1 DAC is enabled.
14 VRSEL	Supply Voltage Reference Source Select
	0 Vin1 is selected as resistor ladder network supply reference Vin.
13–11	1 Vin2 is selected as resistor ladder network supply reference Vin.
PSEL	Plus Input MUX Control
	Determines which input is selected for the plus mux.
	NOTE: These bits are used to select the external 8 inputs for the plus mux, the actual input to the positive port of the comparator is selected between this mux out and other inputs finally, see the definition in INPSEL.
	Note: For the round robin mode of operation, the MSEL and PSEL bitfields in CMPx_C1 register must have different values.
	000 INO
	001 IN1 010 IN2
	011 IN3
	100 IN4
	101 IN5
	110 IN6 111 IN7
10–8	Minus Input MUX Control
MSEL	Determines which input is selected for the minus mux.

Table continues on the next page...

Memory map/register definitions

CMPx_C1 field descriptions (continued)

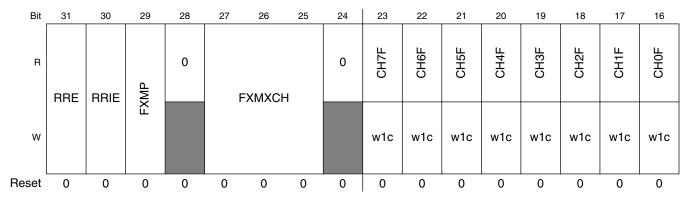
Field	Description					
	NOTE: These bits are used to select the external 8 inputs for the minus mux, the actual input to the negative port of the comparator is selected between this mux out and other inputs finally, see the definition in INNSEL.					
	Note: For the round robin mode of operation, the MSEL and PSEL bitfields in CMPx_C1 register must have different values.					
	000 IN0					
	001 IN1					
	010 IN2					
	011 IN3					
	100 IN4					
	101 IN5					
	110 IN6					
	111 IN7					
VOSEL	DAC Output Voltage Select					
	This bit selects an output voltage from one of 256 distinct levels. DACO = $(Vin/256) \times (VOSEL[7:0] + 1)$, so the DACO range is from Vin/256 to Vin.					

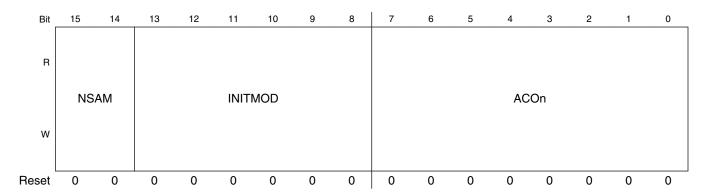
37.8.3 CMP Control Register 2 (CMPx_C2)

Access:

- Supervisor read/write
- User read/write

Address: Base address + 8h offset





CMPx_C2 field descriptions

Field	Description					
31 RRE	Round-Robin Enable					
	This bit enables the round-robin operation.					
	0 Round-robin operation is disabled.					
	1 Round-robin operation is enabled.					
30 RRIE	Round-Robin interrupt enable					
	This bit enables the interrupt/wake-up when the comparison result changes for a given channel.					
	0 The round-robin interrupt is disabled.					
	1 The round-robin interrupt is enabled when a comparison result changes from the last sample.					
29 FXMP	Fixed MUX Port					
	This bit is used to fix the analog mux port for the round-robin mode.					
	0 The Plus port is fixed. Only the inputs to the Minus port are swept in each round.					
	1 The Minus port is fixed. Only the inputs to the Plus port are swept in each round.					
28	This field is reserved.					
Reserved	This read-only field is reserved and always has the value 0.					
27–25 FXMXCH	Fixed channel selection					
	This field indicates which channel in the mux port is fixed in a given round-robin mode.					
	000 Channel 0 is selected as the fixed reference input for the fixed mux port.					
	001 Channel 1 is selected as the fixed reference input for the fixed mux port.					
	010 Channel 2 is selected as the fixed reference input for the fixed mux port.					
	O11 Channel 3 is selected as the fixed reference input for the fixed mux port.					
	100 Channel 4 is selected as the fixed reference input for the fixed mux port.					
	101 Channel 5 is selected as the fixed reference input for the fixed mux port.					
	110 Channel 6 is selected as the fixed reference input for the fixed mux port.					
	111 Channel 7 is selected as the fixed reference input for the fixed mux port.					
24 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.					
23 CH7F	Channel 7 input changed flag. This bit is set if the channel 7 input changed from the last comparison with the fixed mux port.					

Table continues on the next page...

CMP functional description

CMPx_C2 field descriptions (continued)

Field	Description						
22 CH6F	Channel 6 input changed flag. This bit is set if the channel 6 input changed from the last comparison with the fixed mux port.						
21 CH5F	Channel 5 input changed flag. This bit is set if the channel 5 input changed from the last comparison with the fixed mux port.						
20 CH4F	Channel 4 input changed flag. This bit is set if the channel 4 input changed from the last comparison with the fixed mux port.						
19 CH3F	Channel 3 input changed flag. This bit is set if the channel 3 input changed from the last comparison with the fixed mux port.						
18 CH2F	Channel 2 input changed flag. This bit is set if the channel 2 input changed from the last comparison with the fixed mux port.						
17 CH1F	Channel 1 input changed flag. This bit is set if the channel 1 input changed from the last comparison with the fixed mux port.						
16 CH0F	Channel 0 input changed flag. This bit is set if the channel 0 input changed from the last comparison with the fixed mux port.						
15–14 NSAM	Number of sample clocks For a given channel, this field specifies how many round-robin clock cycles later the sample takes place. On The comparison result is sampled as soon as the active channel is scanned in one round-robin clock. The sampling takes place 1 round-robin clock cycle after the next cycle of the round-robin clock. The sampling takes place 2 round-robin clock cycles after the next cycle of the round-robin clock.						
	11 The sampling takes place 3 round-robin clock cycles after the next cycle of the round-robin clock.						
13–8 INITMOD	Comparator and DAC initialization delay modulus. These values specify the round robin clock cycles used to determine the comparator and DAC initialization delays specified by the datasheet. For example the initialization delay is 80us and the round robin clock is 100kHz, then INITMOD should be set to 80us/10us = 8.						
	000000 The modulus is set to 64 (same with 111111). other values Initialization delay is set to INITMOD × round robin clock period						
ACOn	The result of the input comparison for channel n . This field stores the latest comparison result of the input channel n with the fixed mux port. Reading this bit returns the latest comparison result. Writing this field defines the pre-set state of channel n .						

37.9 CMP functional description

The CMP module can be used to compare two analog input voltages applied to INP and INM. CMPO is high when the non-inverting input is greater than the inverting input, and is low when the non-inverting input is less than the inverting input. This signal can be selectively inverted by setting C0[INVT] = 1.

C0[IER] and C0[IEF] are used to select the condition that causes the CMP module to assert an interrupt to the processor. C0[CFF] is set on a falling edge, and C0[CFR] is set on a rising edge of the comparator output. The optionally filtered CMPO can be read directly through C0[COUT].

37.9.1 Initialization

A typical startup sequence is as follows.

The time required to stabilize COUT is the power-on delay of the comparators plus the largest propagation delay from a selected analog source through the analog comparator, windowing function, and filter. See the datasheet for power-on delays of the comparators. The windowing function has a maximum of one bus clock period delay. The filter delay is specified in the Low-pass filter section.

During operation, the propagation delay of the selected data paths must always be considered. It may take many bus clock cycles for COUT and C0[CFR]/C0[CFF] to reflect an input change or a configuration change to one of the components involved in the data path.

When programmed for filtering modes, COUT initially equals 0 until sufficient clock cycles have elapsed to fill all stages of the filter. This occurs even if COUTA is at a logic 1.

37.9.2 Low-pass filter

The low-pass filter operates on the unfiltered and unsynchronized and optionally inverted comparator output COUTA and generates the filtered and synchronized output COUT. Both COUTA and COUT can be configured as module outputs and are used for different purposes within the system.

Synchronization and edge detection are always used to determine status register bit values. They also apply to COUT for all sampling and windowed modes. Filtering can be performed using an internal timebase defined by FPR[FILT_PER], or using an external SAMPLE input to determine sample time.

The need for digital filtering and the amount of filtering is dependent on user requirements. Filtering can become more useful in the absence of an external hysteresis circuit. Without external hysteresis, high-frequency oscillations can be generated at COUTA when the selected INM and INP input voltages differ by less than the offset voltage of the differential comparator.

37.9.2.1 Enabling filter modes

Filter modes can be enabled by:

CMP functional description

- Setting C0[FILTER_CNT] > 0x01 and
- Setting C0[FPR] to a nonzero value or setting C0[SE]=1

If using the divided bus clock to drive the filter, it samples COUTA every C0[FPR] bus clock cycles.

The filter output is at logic 0 when first initalized, and subsequently changes when all the consecutive C0[FILTER_CNT] samples agree that the output value has changed. In other words, C0[COUT] is 0 for some initial period, even when COUTA is at logic 1.

Setting all of C0[SE], C0[FPR] and C0[FILTER_CNT] to 0 disables the filter and eliminates switching current associated with the filtering process.

Note

Always switch to this setting prior to making any changes in filter parameters. This resets the filter to a known state. Switching C0[FILTER_CNT] on the fly without this intermediate step can result in unexpected behavior.

If C0[SE]=1, the filter samples COUTA on each positive transition of the sample input. The output state of the filter changes when all the consecutive C0[FILTER_CNT] samples agree that the output value has changed.

37.9.2.2 Latency issues

The value of C0[FPR] or SAMPLE period must be set such that the sampling period is just longer than the period of the expected noise. This way a noise spike will corrupt only one sample. The value of C0[FILTER_CNT] must be chosen to reduce the probability of noisy samples causing an incorrect transition to be recognized. The probability of an incorrect transition is defined as the probability of an incorrect sample raised to the power of C0[FILTER_CNT].

The values of C0[FPR] or SAMPLE period and C0[FILTER_CNT] must also be traded off against the desire for minimal latency in recognizing actual comparator output transitions. The probability of detecting an actual output change within the nominal latency is the probability of a correct sample raised to the power of C0[FILTER_CNT].

The following table summarizes maximum latency values for the various modes of operation *in the absence of noise*. Filtering latency is restarted each time an actual output transition is masked by noise.

Table 37-4. Comparator sample/filter maximum latencies

Mode #	C0[E N]	C0[W	C0[S E]	C0[FILTER_ CNT]	Co[FPR]	Operation	Maximum latency ¹
1	0	Х	Х	Х	Х	Disabled	N/A
2A	1	0	0	0x00	Х	Continuous Mode	T _{PD}
2B	1	0	0	Х	0x00		
3A	1	0	1	0x01	Х	Sampled, Non-Filtered mode	T _{PD} + T _{SAMPLE} + T _{per}
3B	1	0	0	0x01	> 0x00		T _{PD} + (C0[FPR] * T _{per}) + T _{per}
4A	1	0	1	> 0x01	Х	Sampled, Filtered mode	T _{PD} + (C0[FILTER_CNT] * T _{SAMPLE}) + T _{per}
4B	1	0	0	> 0x01	> 0x00		T _{PD} + (C0[FILTER_CNT] * C0[FPR] x T _{per}) + T _{per}
5A	1	1	0	0x00	Х	Windowed mode	T _{PD} + T _{per}
5B	1	1	0	Х	0x00		T _{PD} + T _{per}
6	1	1	0	0x01	0x01 - 0xFF	Windowed / Resampled mode	T _{PD} + (C0[FPR] * T _{per}) + 2T _{per}
7	1	1	0	> 0x01	0x01 - 0xFF	Windowed / Filtered mode	T _{PD} + (C0[FILTER_CNT] * C0[FPR] x T _{per}) + 2T _{per}

T_{PD} represents the intrinsic delay of the analog component plus the polarity select logic. T_{SAMPLE} is the clock period of the external sample clock. T_{per} is the period of the bus clock.

37.10 Interrupts

The CMP module is capable of generating an interrupt on either the rising- or fallingedge of the comparator output, or both. Assuming the CMP DMA enable bit is not set, the following table gives the conditions in which the interrupt request is asserted and deasserted.

Table 37-5. CMP interrupt generations

When	Then
C0[IER] and C0[CFR] are set	The interrupt request is asserted
C0[IEF] and C0[CFF] are set	The interrupt request is asserted
C0[IER] and C0[CFR] are cleared for a rising-edge interrupt	The interrupt request is deasserted
C0[IEF] and C0[CFF] are cleared for a falling-edge interrupt	The interrupt request is deasserted

37.11 DMA support

Normally, the CMP generates a CPU interrupt if there is a change on the COUT. When DMA support is enabled by setting C0[DMAEN] and the interrupt is enabled by setting C0[IER], C0[IEF], or both, the corresponding change on COUT forces a DMA transfer request rather than a CPU interrupt instead. When the DMA has completed the transfer, it sends a transfer completing indicator signal that deasserts the DMA transfer request and clears the flag to allow a subsequent change on comparator output to occur and force another DMA request.

37.12 DAC functional description

This section provides DAC functional description.

37.12.1 Digital-to-analog converter block diagram

The following figure shows the block diagram of the DAC module. It contains a 256-tap resistor ladder network and a 256-to-1 multiplexer, which selects an output voltage from one of 256 distinct levels that outputs from DACO. It is controlled through the Control register 1 (CMP_C1). Its supply reference source can be selected from two sources V_{in1} and V_{in2} . The module can be powered down or disabled when not in use. When in the Disabled mode, DACO is connected to the analog ground.

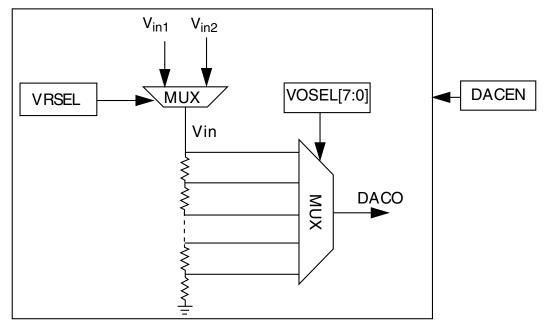


Figure 37-15. 8-bit DAC block diagram

37.12.2 DAC resets

This module has a single reset input, corresponding to the chip-wide peripheral reset.

37.12.3 DAC clocks

This module has a single clock input, the bus clock.

37.12.4 DAC interrupts

This module has no interrupts.

37.13 Trigger mode

The CMP and the 8-bit DAC are designed to support the trigger mode operation, which is enabled when the MCU enters STOP modes with C2[RRE] and C0[EN] are set.

With this mode enabled, the trigger events that include the operation clock and a trigger start signal will initiate a compare sequence that must first enable the CMP and DAC prior to performing a CMP operation and capturing the output. A fixed channel for either the plus-side mux or the minus-side mux is selected by software via C2[FXMP] and

Trigger mode

C2[FXMXCH]. It is a mandatory request that the round-robin cycling period must be set longer than the time that all the active channels complete the specified comparison cycles set by C2[NSAM].

The active channels selected by C1[CHNn] are then routed to the non-fixed channel mux and compared with the reference input in a round-robin manner. In order to meet the comparator stabilization time, after the configurable number of operation clocks defined by C2[NSAM], the comparison result is sampled for the selected channel. A software pre-programmed state for each channel is configured by writing to C2[ACOn] field. After all the active channels are sampled, if the comparison result changes from its pre-programmed state, the corresponding flag in C2[CHnF] is set. If C2[RRIE] is set, an asynchronous reset is asserted to bring the MCU out of STOP mode.

NOTE

These flags do not support generating a DMA transfer event.

This mode is active when the MCU is in STOP mode, so none of the window/filter functions are available. A basic assumption of this mode is that the selected inputs are changing at a much slower rate than the operation clock. It is suggested to configure the comparator in low power comparison mode as well. In programming the C2[INITMOD] registers, the INITMOD × round-robin clock period must be longer than the initialization delay, which can be referred from the chip datasheet.

The following diagram shows the basic flow of this mode. In the diagram, C1[CHN1], C1[CHN3], and C1[CHN7] are set, so channels #1, #3, and #7 are selected for roundrobin. C2[NSAM] is set to 2'b01, so one clock later the comparison result of the selected channel is sampled. When channel #7 is compared, the result is sampled, and round-robin ends. If any of the comparison results from channel #1, #3, or #7 changed from their programmed value (written to C2[ACO1], C2[ACO3], and C2[ACO7]), an interrupt is generated to wake up the MCU from the STOP mode. Software can then poll the C2[CH*n*F] to see which channel input(s) changed value during the STOP mode.

NOTE

In round-robin mode, it should be ensured that the RTC_CLK period is greater than the comparison time corresponding to the value of C0[PMODE]. It is also required to **not** select the internal reserved channels for round-robin by INPSEL and INNSEL.

NOTE

In round-robin mode, it is suggested to always configure the DAC output as the fixed port reference.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

NOTE

In round-robin mode, current injection or over-voltage is not supported on the input channels.

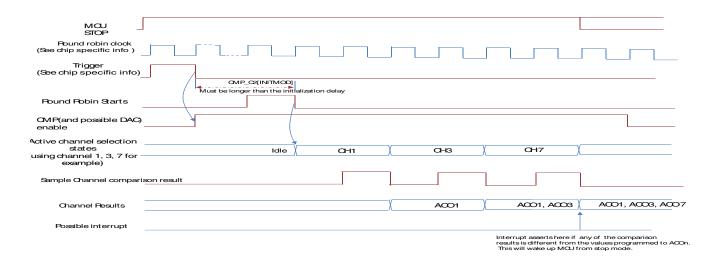


Figure 37-16. Trigger mode

The following table shows the channel decoding in both functional mode and trigger mode. Other cases not listed in the table are illegal.

Table 37-6. CMP channel decoding in functional mode and trigger mode

Mode	RRE	PSEL[2:0]	MSEL[2:0]	INPSE L[1:0]	INNSE L[1:0]	FXMP	FXMX CH[2:0	CHNx	INP	INN	CMP Behavior
Functional Mode	0	x ¹	0~7	0	1	x	x	x	DAC	Channel decoded from MSEL[2:0]	Channel 0~7 can be compared with DAC
		0~7	x	1	0	x	x	x	Channel decoded from PSEL[2:0]	DAC	Channel 0~7 can be compared with DAC
		0~7	0~7	1	1	х	x	х	Channel decoded from PSEL[2:0]	Channel decoded from MSEL[2:0]	Channel 0~7 can be compared with channel 0~7 ²
Trigger Mode	1	х	х	0	1	0	х	0~7	DAC	Channel sweep (CHNx)	Channel 0~7 can be swept with DAC
		х	х	1	0	1	х	0~7	Channel sweep (CHNx)	DAC	Channel 0~7 can be swept with DAC

Table continues on the next page...

Usage Guide

Table 37-6. CMP channel decoding in functional mode and trigger mode (continued)

	Mode	RRE	PSEL[2:0]	MSEL[2:0]	INPSE L[1:0]	INNSE L[1:0]	FXMP	FXMX CH[2:0	CHNx	INP	INN	CMP Behavior
		x	x	1	1	0	0~7	0~7	Channel fixed by FXMXCH[2:0]	Channel sweep (CHNx)	Channel 0~7 can be swept with a fixed channel (0~7) ³	
		x x 1 1 1	1	0~7	0~7	Channel sweep (CHNx)	Channel fixed by FXMXCH[2:0]	Channel 0~7 can be swept with a fixed channel (0~7) ³				

- 1. "x" means "do not care".
- 2. PSEL should not be set the same as MSEL.
- 3. Channel in the sweep side should not be the same as the fixed side.

37.14 Usage Guide

37.14.1 Zero Crossing Detection

A zero-crossing is a point where the sign of a signal's mathematical function changes (e.g. from positive to negative), represented by a crossing of the axis (zero value) in the graph of the signal function. It is a commonly used in electronics application especially for systems which send digital data over AC circuits.

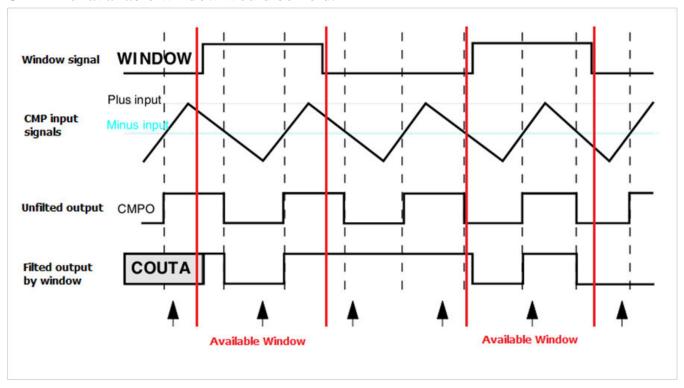
When in some cases, the "Zero point" could be other voltage than actual 0 V. This "Zero point" would be used to judge whether the indicated voltage level is reached. In this situation, the internal DAC could generate the reference voltage level for "Zero point" to make the comparison with the other input channel of CMP module, and then output the result of logic "0" and "1".

To enable the internal DAC and set it as the comparator's input of minus side, the code could be as follow:

Then, the CMP output interrupts with their flags would be used to indicate the event of Zero Crossing Detection.

37.14.2 Window Mode

This mode could be used to create a kind of filter for input signal. When enabling the window mode, the compare would only launch the comparison in available window, which could be generated by some timer modules (e.g. PDB or LPIT). And output of CMP in unavailable window would be hold.



To enable the window mode for CMP, the code could be as follows:

```
/* Enable the window mode and disable the sample mode. */
CMPx_C0 = (CMPx_C0 & ~ CMP_C0_SE_MASK ) | CMP_C0_WE_MASK;
```

Then enable the window's generator (to produce the WINDOW signal) of related module.

For detailed information about CMP's window feature, please see to section "Windowed mode" in this chapter.

37.14.3 **Round Robin Mode**

This mode compares multiple input channels with the reference input channel (fixed) in a round-robin manner. It is commonly used to provide a trigger mode to wake up the MCU in STOP mode.

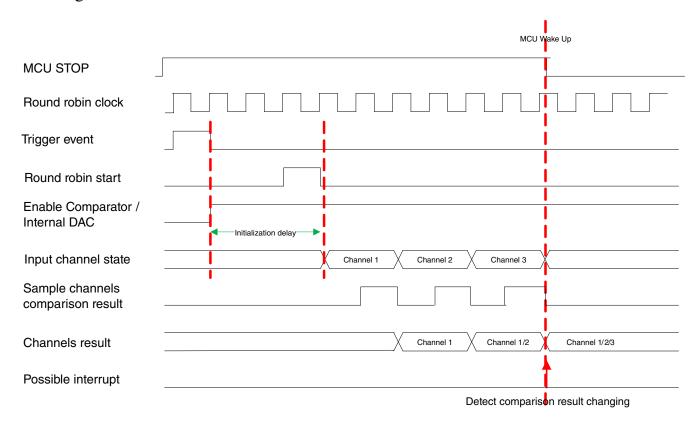
Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018 **NXP Semiconductors** 817

Usage Guide

This mode needs some trigger events to work. The trigger events include the operation clock and a trigger start signal which can be provided by other module (e.g. LPTMR).

Round robin mode works as follows:

- 1. The trigger start signal will enable the comparator and internal DAC in the initialization delay period;
- 2. The comparator will then compare the multiple input channels with the reference input channel in turn under the operation clock until all input channels complete comparison;
- 3. If current comparison result is different with the pre-set state or the previous comparison result and round robin interrupt is enabled, an interrupt will generate to bring the MCU out of STOP mode.



The code snippet to enable the round robin mode is:

Chapter 37 Comparator (CMP)

VP 0

Usage Guide

Chapter 38Programmable Delay Block (PDB)

38.1 Chip-specific Information for this Module

38.1.1 Instantiation Information

There is one PDB module on this device. The PDB feature configuration is shown in the following table.

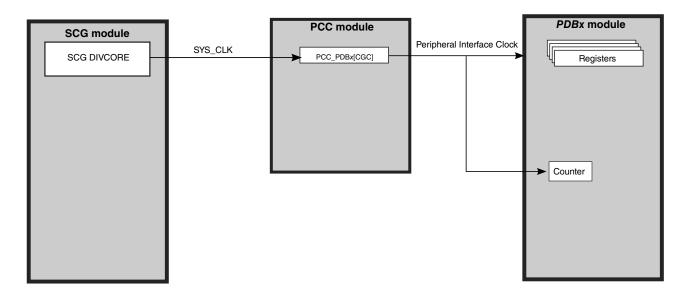
Table 38-1. PDB Configuration

PDB Feature	PDB0	Description
Number of PDB channels for ADC hardware trigger		Each PDB channel supports one hardware trigger for one ADC.
Number of pre-triggers for ADC channel select per PDB channel		PDB pre-triggers are used to select ADC channel for the ADC hardware trigger. Pre-trigger number matches ADC channel number.
Number of Pulse Out	2	Pulse Out connects to TRGMUX
Number of DAC interval triggers	0	

38.1.2 PDB Clocking Information

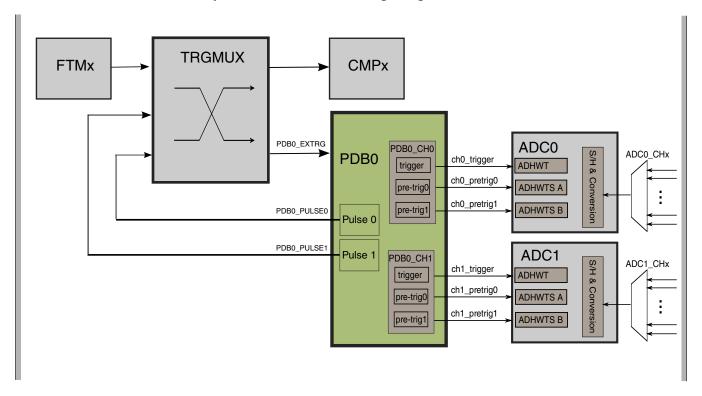
The PDB module is only clocked by system clock shown in following diagram.

Peripheral Clocking - PDB



38.1.3 Inter-connectivity Information

The PDB inter-connectivity is shown in following diagram.



On this device, the PDB trigger source selection is implemented through the TRGMUX module. For each PDB unit, there is only one trigger input from TRGMUX, but TRGMUX supports different trigger sources. The trigger input from TRGMUX is connecting with PDB trigger input0, the trigger input 1 -14 are reserved. PDB trigger inputs are shown in following table:

Table 38-2. PDB Trigger Inputs

PDB0_SC[TRGSEL]	PDB0 Trigger Inputs	Inter-connectivity
0000	Trigger input0	TRGMUX_PDB0_EXTRG
0001 - 1110	Trigger input1 - 14	Reserved
1111	Software trigger	

The PDB channels are used to work as ADC hardware triggers. The PDB pulse outs connect to TRGMUX as trigger sources for other modules, like CMP.

Table 38-3. PDB Trigger Outputs

PDB Trigger Outputs	Inter-connectivity
PDB0 channel 0	ADC0 hardware trigger
PDB0 channel 1	ADC1 hardware trigger
PDB0 pulse out 0	Pulse out 0 connects to TRGMUX
PDB0 pulse out 1	Pulse out 1 connects to TRGMUX

Back-to-back acknowledge connectivity:

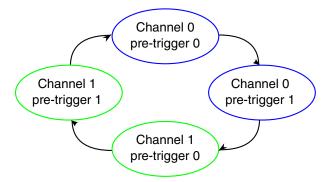
Back-to-back operation enables the ADC conversions complete to trigger the next PDB channel pre-trigger and trigger output.

The PDB back-to-back operation acknowledgement connections are implemented inside each PDB unit as a ring. The following list is an example for PDB0.

- PDB channel 0 trigger/pre-trigger 0 acknowledgement input: ADC1SC1B_COCO
- PDB channel 0 trigger/pre-trigger 1 acknowledgement input: ADC0SC1A_COCO
- PDB channel 1 trigger/pre-trigger 0 acknowledgement input: ADC0SC1B_COCO
- PDB channel 1 trigger/pre-trigger 1 acknowledgement input: ADC1SC1A_COCO

The back-to-back chain diagram is as follows:

Introduction



38.2 Introduction

The Programmable Delay Block (PDB) provides controllable delays from either an internal or an external trigger, or a programmable interval tick, to the hardware trigger inputs of ADCs. The PDB can optionally provide pulse outputs (Pulse-Out's) that are used as the sample window in the CMP block.

38.2.1 Features

- Up to 15 trigger input sources and one software trigger source
- Up to 8 configurable PDB channels for ADC hardware trigger
 - One PDB channel is associated with one ADC
 - One trigger output for ADC hardware trigger and up to 8 pre-trigger outputs for ADC trigger select per PDB channel
 - Trigger outputs can be enabled or disabled independently
 - One 16-bit delay register per pre-trigger output
 - Optional bypass of the delay registers of the pre-trigger outputs
 - Operation in One-Shot or Continuous modes
 - Optional back-to-back mode operation, which enables the ADC conversions complete to trigger the next PDB channel
 - One programmable delay interrupt
 - One sequence error interrupt

- One channel flag and one sequence error flag per pre-trigger
- DMA support
- Up to 8 pulse outputs (pulse-out's)
 - Pulse-out's can be enabled or disabled independently
 - Programmable pulse width

NOTE

The number of PDB input and output triggers are chip-specific. See the chip-specific PDB information for details.

38.2.2 Implementation

In this section, the following letters refer to the number of output triggers:

- N—Total available number of PDB channels.
- n—PDB channel number, valid from 0 to *N*-1.
- M—Total available pre-trigger per PDB channel.
- m—Pre-trigger number, valid from 0 to *M*-1.
- Y—Total number of Pulse-Out's.
- y—Pulse-Out number, valid value is from 0 to Y-1.

NOTE

The number of module output triggers to core is chip-specific. For module to core output triggers implementation, see the chip configuration information.

38.2.3 Back-to-back acknowledgment connections

PDB back-to-back operation acknowledgment connections are chip-specific. For implementation, see the chip configuration information.

38.2.4 Block diagram

This diagram illustrates the major components of the PDB.

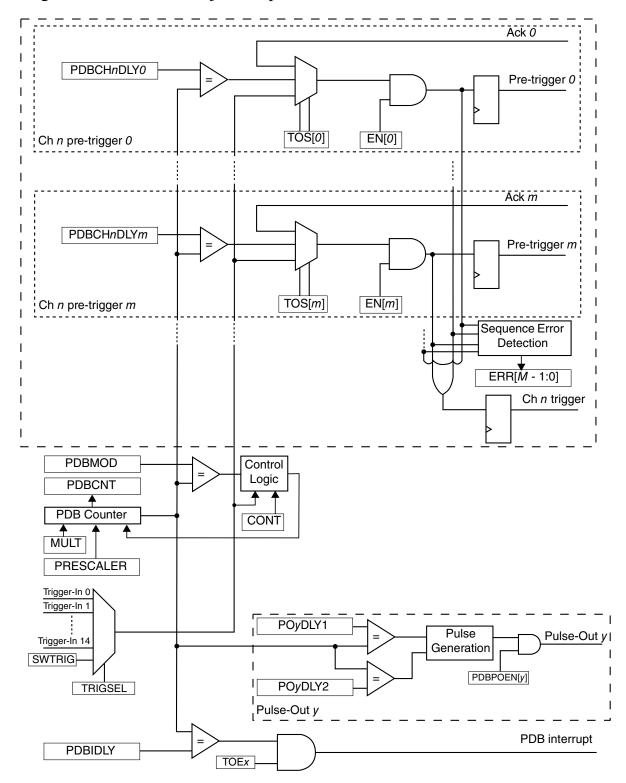


Figure 38-1. PDB block diagram

In this diagram, only one PDB channel *n*, and one Pulse-Out *y* are shown. The PDB-enabled control logic and the sequence error interrupt logic are not shown.

38.2.5 Modes of operation

PDB ADC trigger operates in the following modes:

- Disabled—Counter is off, all pre-trigger and trigger outputs are low if PDB is not in back-to-back operation of Bypass mode.
- Debug—Counter is paused when processor is in Debug mode.
- Enabled One-Shot—Counter is enabled and restarted at count zero upon receiving a positive edge on the selected trigger input source or software trigger is selected and SC[SWTRIG] is written with 1. In each PDB channel, an enabled pre-trigger asserts once per trigger input event. The trigger output asserts whenever any of the pre-triggers is asserted.
- Enabled Continuous—Counter is enabled and restarted at count zero. The counter is rolled over to zero again when the count reaches the value specified in the modulus register, and the counting is restarted. This enables a continuous stream of pretriggers/trigger outputs as a result of a single trigger input event.
- Enabled Bypassed—The pre-trigger and trigger outputs assert immediately after a positive edge on the selected trigger input source or software trigger is selected and SC[SWTRIG] is written with 1, that is the delay registers are bypassed. It is possible to bypass any one or more of the delay registers; therefore, this mode can be used in conjunction with One-Shot or Continuous mode.

38.3 PDB signal descriptions

This table shows the detailed description of the external signal.

Table 38-4. PDB signal descriptions

Signal	Description	I/O
EXTRG	External Trigger Input Source	I
	If the PDB is enabled and external trigger input source is selected, a positive edge on the EXTRG signal resets and starts the counter.	

38.4 Memory map and register definition

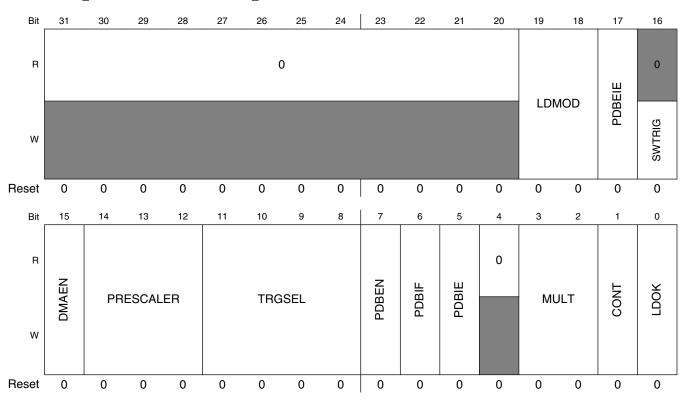
Memory map and register definition

PDB memory map

Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page
4003_6000	Status and Control register (PDB0_SC)	32	R/W	0000_0000h	38.4.1/829
4003_6004	Modulus register (PDB0_MOD)	32	R/W	0000_FFFFh	38.4.2/832
4003_6008	Counter register (PDB0_CNT)	32	R	0000_0000h	38.4.3/832
4003_600C	Interrupt Delay register (PDB0_IDLY)	32	R/W	0000_FFFFh	38.4.4/833
4003_6010	Channel n Control register 1 (PDB0_CH0C1)	32	R/W	0000_0000h	38.4.5/833
4003_6014	Channel n Status register (PDB0_CH0S)	32	R/W	0000_0000h	38.4.6/834
4003_6018	Channel n Delay 0 register (PDB0_CH0DLY0)	32	R/W	0000_0000h	38.4.7/835
4003_601C	Channel n Delay 1 register (PDB0_CH0DLY1)	32	R/W	0000_0000h	38.4.8/836
4003_6038	Channel n Control register 1 (PDB0_CH1C1)	32	R/W	0000_0000h	38.4.5/833
4003_603C	Channel n Status register (PDB0_CH1S)	32	R/W	0000_0000h	38.4.6/834
4003_6040	Channel n Delay 0 register (PDB0_CH1DLY0)	32	R/W	0000_0000h	38.4.7/835
4003_6044	Channel n Delay 1 register (PDB0_CH1DLY1)	32	R/W	0000_0000h	38.4.8/836
4003_6190	Pulse-Out n Enable register (PDB0_POEN)	32	R/W	0000_0000h	38.4.9/836
4003_6194	Pulse-Out n Delay register (PDB0_PO0DLY)	32	R/W	0000_0000h	38.4.10/ 837
4003_6198	Pulse-Out n Delay register (PDB0_PO1DLY)	32	R/W	0000_0000h	38.4.10/ 837

38.4.1 Status and Control register (PDBx_SC)

Address: 4003_6000h base + 0h offset = 4003_6000h



PDBx_SC field descriptions

Field	Description
31–20 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
19–18 LDMOD	Load Mode Select Selects the mode to load the MOD, IDLY, CHnDLYm, INTx, and POyDLY registers, after 1 is written to LDOK.
	 The internal registers are loaded with the values from their buffers, immediately after 1 is written to LDOK. The internal registers are loaded with the values from their buffers when the PDB counter (CNT) =
	 MOD + 1 CNT delay elapsed, after 1 is written to LDOK. The internal registers are loaded with the values from their buffers when a trigger input event is detected, after 1 is written to LDOK.
	11 The internal registers are loaded with the values from their buffers when either the PDB counter (CNT) = MOD + 1 CNT delay elapsed, or a trigger input event is detected, after 1 is written to LDOK.
17 PDBEIE	PDB Sequence Error Interrupt Enable Enables the PDB sequence error interrupt. When PDBEIE is set, any of the PDB channel sequence error flags generates a PDB sequence error interrupt.

Table continues on the next page...

Memory map and register definition

PDBx_SC field descriptions (continued)

Field	Description
	PDB sequence error interrupt disabled.
	1 PDB sequence error interrupt enabled.
16 SWTRIG	Software Trigger
SWINIC	When PDB is enabled and the software trigger is selected as the trigger input source, writing 1 to SWTRIG resets and restarts the counter. Writing 0 to SWTRIG has no effect. Reading SWTRIG yields 0.
15 DMAEN	DMA Enable
	When DMA is enabled, the PDBIF flag generates a DMA request instead of an interrupt.
	0 DMA disabled.
	1 DMA enabled.
14–12 PRESCALER	Prescaler Divider Select
	Counting uses the peripheral clock divided by the product of a factor (selected by MULT field) and an integer factor (set by PRESCALAR field), or in other words, (peripheral clock)/(MULT x PRESCALAR).
	O00 Counting uses the peripheral clock divided by MULT (the multiplication factor).
	001 Counting uses the peripheral clock divided by 2 x MULT (the multiplication factor).
	010 Counting uses the peripheral clock divided by 4 x MULT (the multiplication factor).
	011 Counting uses the peripheral clock divided by 8 x MULT (the multiplication factor).
	100 Counting uses the peripheral clock divided by 16 x MULT (the multiplication factor).
	101 Counting uses the peripheral clock divided by 32 x MULT (the multiplication factor).
	110 Counting uses the peripheral clock divided by 64 x MULT (the multiplication factor).
	111 Counting uses the peripheral clock divided by 128 x MULT (the multiplication factor).
11–8 TRGSEL	Trigger Input Source Select
MOLL	Selects the trigger input source for the PDB. The trigger input source can be internal or external (EXTRG pin), or the software trigger. Refer to chip configuration details for the actual PDB input trigger connections.
	0000 Trigger-In 0 is selected.
	0001 Trigger-In 1 is selected.
	0010 Trigger-In 2 is selected.
	0011 Trigger-In 3 is selected.
	0100 Trigger-In 4 is selected.
	0101 Trigger-In 5 is selected.
	0110 Trigger-In 6 is selected.
	0111 Trigger-In 7 is selected.
	1000 Trigger-In 8 is selected.
	1001 Trigger-In 9 is selected.
	1010 Trigger-In 10 is selected.
	1011 Trigger-In 11 is selected.
	1100 Trigger-In 12 is selected.
	1101 Trigger-In 13 is selected.
	1110 Trigger-In 14 is selected.
	1111 Software trigger is selected.
7	PDB Enable
PDBEN	

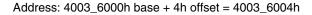
Table continues on the next page...

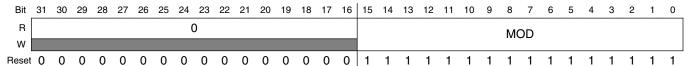
PDBx_SC field descriptions (continued)

Field	Description
	0 PDB disabled. Counter is off.
	1 PDB enabled.
6 PDBIF	PDB Interrupt Flag
FDBIF	PDBIF is set when the counter value is equal to the IDLY register + 1.
	Write zero to clear PDBIF.
_	Writing 1 to PDBIF has no effect.
5 PDBIE	PDB Interrupt Enable
1 DDIE	Enables the PDB interrupt. When PDBIE is set and DMAEN is cleared, PDBIF generates a PDB interrupt.
	0 PDB interrupt disabled.
	1 PDB interrupt enabled.
4 .	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
3–2 MULT	Multiplication Factor Select for Prescaler
WOLI	Selects the multiplication factor of the prescaler divider for the counter clock.
	00 Multiplication factor is 1.
	01 Multiplication factor is 10.
	10 Multiplication factor is 20.
	11 Multiplication factor is 40.
1 CONT	Continuous Mode Enable
CONT	Enables the PDB operation in Continuous mode.
	0 PDB operation in One-Shot mode
	1 PDB operation in Continuous mode
0 LDOK	Load OK
EBOIX	Writing 1 to LDOK bit updates the MOD, IDLY, CHnDLYm, and POyDLY registers with the values previously written to their internal buffers (and stored there). The new values of MOD, IDLY, CHnDLYm, and POyDLY registers will take effect according to the setting of the LDMOD field (Load Mode Select). Before 1 is written to the LDOK field, the values in the internal buffers of these registers are not effective, and new values cannot be written to the internal buffers until the existing values in the internal buffers are loaded into their corresponding registers. • LDOK can be written only when PDBEN is set, or LDOK can be written at the same time when PDBEN is written to 1. • LDOK is automatically cleared when the values in the internal buffers are loaded into the registers or when PDBEN bit (PDB Enable) is cleared. • Writing 0 to LDOK has no effect.

38.4.2 Modulus register (PDBx_MOD)

Note: This register is internally buffered, and any values written to the register are written to its internal buffer instead; in other words, the internal device bus does not write directly to this register. The value in this register's internal buffer is loaded into this register only after "1" is written to the SC[LDOK] bit.





PDBx_MOD field descriptions

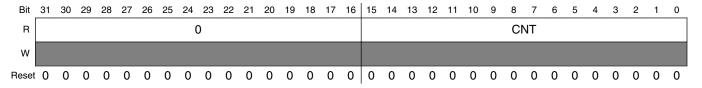
Field	Description
31–16 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
MOD	PDB Modulus
	Specifies the period of the counter. When the counter reaches this value, it will be reset back to zero. If the PDB is in Continuous mode, the count begins anew. Reading this field returns the value of the internal register that is effective for the current cycle of PDB.

38.4.3 Counter register (PDBx_CNT)

NOTE

Writing to this read-only register will generate a transfer error (and possibly a hard fault).

Address: 4003_6000h base + 8h offset = 4003_6008h



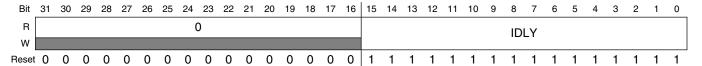
PDBx_CNT field descriptions

Field	Description
31–16	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
CNT	PDB Counter
	Contains the current value of the counter.

38.4.4 Interrupt Delay register (PDBx_IDLY)

Note: This register is internally buffered, and any values written to the register are written to its internal buffer instead; in other words, the internal device bus does not write directly to this register. The value in this register's internal buffer is loaded into this register only after "1" is written to the SC[LDOK] bit.

Address: 4003_6000h base + Ch offset = 4003_600Ch



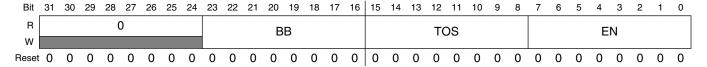
PDBx_IDLY field descriptions

Field	Description
31–16 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
IDLY	PDB Interrupt Delay Specifies the delay value to schedule the PDB interrupt. It can be used to schedule an independent interrupt at some point in the PDB cycle. If enabled, a PDB interrupt is generated, when the counter is equal to the IDLY. Reading this field returns the value of internal register that is effective for the current cycle of the PDB.

38.4.5 Channel n Control register 1 (PDBx_CHnC1)

Each PDB channel has one control register, CHnC1. The bits in this register control the functionality of each PDB channel operation.

Address: 4003_{6000h} base + 10h offset + $(40d \times i)$, where i=0d to 1d



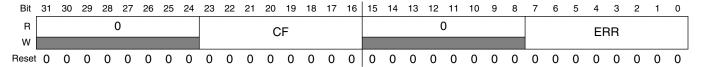
Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

PDBx_CHnC1 field descriptions

Field	Description
31–24	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
23–16 BB	PDB Channel Pre-Trigger Back-to-Back Operation Enable
	These bits enable the PDB ADC pre-trigger operation as back-to-back mode. Only lower M pre-trigger bits are implemented in this MCU. Back-to-back operation enables the ADC conversions complete to trigger the next PDB channel pre-trigger and trigger output, so that the ADC conversions can be triggered on next set of configuration and results registers. Application code must only enable the back-to-back operation of the PDB pre-triggers at the leading of the back-to-back connection chain.
	0 PDB channel's corresponding pre-trigger back-to-back operation disabled. 1 PDB channel's corresponding pre-trigger back-to-back operation enabled.
15–8 TOS	PDB Channel Pre-Trigger Output Select Selects the PDB ADC pre-trigger outputs. Only lower M pre-trigger fields are implemented in this MCU. O PDB channel's corresponding pre-trigger is in bypassed mode. The pre-trigger asserts one peripheral
	clock cycle after a rising edge is detected on selected trigger input source or software trigger is selected and SWTRIG is written with 1.
	1 PDB channel's corresponding pre-trigger asserts when the counter reaches the channel delay register and one peripheral clock cycle after a rising edge is detected on selected trigger input source or software trigger is selected and SWTRIG is written with 1.
EN	PDB Channel Pre-Trigger Enable
	These bits enable the PDB ADC pre-trigger outputs. Only lower M pre-trigger bits are implemented in this MCU.
	0 PDB channel's corresponding pre-trigger disabled.
	1 PDB channel's corresponding pre-trigger enabled.

38.4.6 Channel n Status register (PDBx_CHnS)

Address: 4003_{6000h} base + 14h offset + ($40d \times i$), where i=0d to 1d



PDBx_CHnS field descriptions

Field	Description
31–24 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
23–16 CF	PDB Channel Flags The $CF[m]$ field is set when the PDB counter (PDB_CNT) matches the value $CHnDLYm + 1$. Write 0 to clear CF .

Table continues on the next page...

NXP Semiconductors

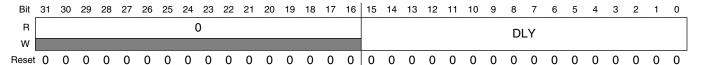
PDBx_CHnS field descriptions (continued)

Field	Description
15–8 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
ERR	PDB Channel Sequence Error Flags Only the lower M bits are implemented in this MCU. Sequence error not detected on PDB channel's corresponding pre-trigger. Sequence error detected on PDB channel's corresponding pre-trigger. ADCn block can be triggered for a conversion by one pre-trigger from PDB channel n. When one conversion, which is triggered by one of the pre-triggers from PDB channel n, is in progress, new trigger from PDB channel's corresponding pre-trigger m cannot be accepted by ADCn, and ERR[m] is set. Writing 0's to clear the sequence error flags.

38.4.7 Channel n Delay 0 register (PDBx_CHnDLY0)

Note: This register is internally buffered, and any values written to the register are written to its internal buffer instead; in other words, the internal device bus does not write directly to this register. The value in this register's internal buffer is loaded into this register only after "1" is written to the SC[LDOK] bit.

Address: 4003_{6000h} base + 18h offset + $(40d \times i)$, where i=0d to 1d

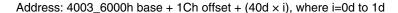


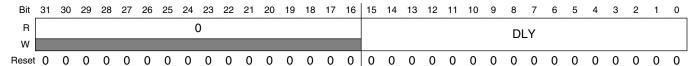
PDBx_CHnDLY0 field descriptions

Field	Description
31–16 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
DLY	PDB Channel Delay Specifies the delay value for the channel's corresponding pre-trigger. The pre-trigger asserts when the counter is equal to DLY. Reading this field returns the value of internal register that is effective for the
	current PDB cycle.

38.4.8 Channel n Delay 1 register (PDBx_CHnDLY1)

Note: This register is internally buffered, and any values written to the register are written to its internal buffer instead; in other words, the internal device bus does not write directly to this register. The value in this register's internal buffer is loaded into this register only after "1" is written to the SC[LDOK] bit.



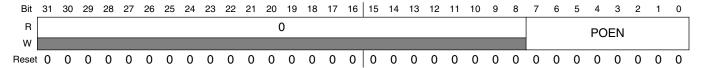


PDBx_CHnDLY1 field descriptions

Field	Description
31–16 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
DLY	PDB Channel Delay These bits specify the delay value for the channel's corresponding pre-trigger. The pre-trigger asserts
	when the counter is equal to DLY. Reading these bits returns the value of internal register that is effective for the current PDB cycle.

38.4.9 Pulse-Out n Enable register (PDBx_POEN)

Address: 4003_6000h base + 190h offset = 4003_6190h



PDBx_POEN field descriptions

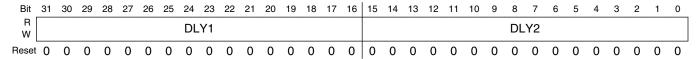
Field	Description
31–8	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
POEN	PDB Pulse-Out Enable
	Enables the pulse output. Only lower 8 bits are implemented in this MCU.
	0 PDB Pulse-Out disabled
	1 PDB Pulse-Out enabled

837

38.4.10 Pulse-Out n Delay register (PDBx_POnDLY)

Note: This register is internally buffered, and any values written to the register are written to its internal buffer instead; in other words, the internal device bus does not write directly to this register. The value in this register's internal buffer is loaded into this register only after "1" is written to the SC[LDOK] bit.

Address: 4003_{6000h} base + 194h offset + $(4d \times i)$, where i=0d to 1d



PDBx_POnDLY field descriptions

Field	Description
31–16 DLY1	PDB Pulse-Out Delay 1
	Specifies the delay 1 value for the PDB Pulse-Out. Pulse-Out goes high when the PDB counter is equal to the DLY1. Reading this field returns the value of internal register that is effective for the current PDB cycle.
DLY2	PDB Pulse-Out Delay 2
	Specifies the delay 2 value for the PDB Pulse-Out. Pulse-Out goes low when the PDB counter is equal to the DLY2. Reading this field returns the value of internal register that is effective for the current PDB cycle.

38.5 Functional description

38.5.1 PDB pre-trigger and trigger outputs

The PDB contains a counter whose output is compared to several different digital values. If the PDB is enabled, then a trigger input event will reset the counter and make it start to count. A trigger input event is defined as a rising edge being detected on a selected trigger input source, or if a software trigger is selected and the Software Trigger bit (SC[SWTRIG]) is written with 1. For each channel, a delay *m* determines the time between assertion of the trigger input event to the time at which changes in the pre-trigger *m* output signal are started. The time is defined as:

Functional description

- Trigger input event to pre-trigger $m = (prescaler \times multiplication factor \times delay m) +$ 2 peripheral clock cycles
- Add 1 additional peripheral clock cycle to determine the time when the channel trigger output changes.

Each channel is associated with 1 ADC block. PDB channel n pre-trigger outputs 0 to M; each pre-trigger output is connected to ADC hardware trigger select and hardware trigger inputs. The pre-triggers are used to precondition the ADC block before the actual trigger occurs. When the ADC receives the rising edge of the trigger, the ADC will start the conversion according to the precondition determined by the pre-triggers. The ADC contains M sets of configuration and result registers, allowing it to alternate conversions between M different analog sources (like a ping-pong game). The pre-trigger outputs are used to specify which signal will be sampled next. When a pre-trigger m is asserted, the ADC conversion is triggered with set m of the configuration and result registers.

The waveforms shown in the following diagram show the pre-trigger and trigger outputs of PDB channel n. The delays can be independently set using the channel delay registers (CHnDLYm), and the pre-triggers can be enabled or disabled using the PDB Channel Pre-Trigger Enables (CHnC1[EN[m]]).

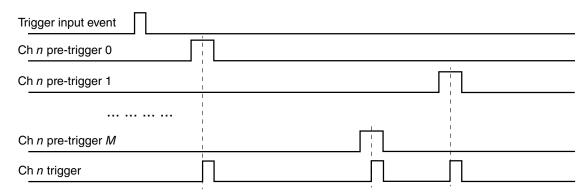


Figure 38-2. Pre-trigger and trigger outputs

The delay in the channel delay register (CHnDLYm) can be optionally bypassed, if the PDB Channel Pre-Trigger Output Select (CHnC1[TOS[m]]) is cleared. In this case, when the trigger input event occurs, the pre-trigger m is asserted after 2 peripheral clock cycles.

The PDB can be configured for back-to-back operation. Back-to-back operation enables the ADC conversion completions to trigger the next PDB channel pre-trigger and trigger outputs, so that the ADC conversions can be triggered on the next set of configuration and results registers. When back-to-back operation is enabled by setting the PDB Channel Pre-Trigger Back-to-Back Operation Enable (CHnC1[BB[m]]), then the delay m

839

is ignored and the pre-trigger *m* is asserted 2 peripheral cycles after the acknowledgment *m* is received. The acknowledgment connections in this MCU are described in Back-to-back acknowledgment connections.

When a pre-trigger from a PDB channel *n* is asserted, the associated lock of the pre-trigger becomes active. The associated lock is released by the rising edge of the corresponding ADC*n*SC1[COCO]; the ADC*n*SC1[COCO] should be cleared after the conversion result is read, so that the next rising edge of ADC*n*SC1[COCO] can be generated to clear the lock later. The lock becomes inactive when:

- the rising edge of corresponding ADCnSC1[COCO] occurs,
- or the corresponding PDB pre-trigger is disabled,
- or the PDB is disabled

The channel n trigger output is suppressed when any of the locks of the pre-triggers in channel n is active.

- If a new pre-trigger *m* asserts when there is active lock in the PDB channel *n*, then a PDB Channel Sequence Error Flag (CH*n*S[ERR[*m*]], associated with the pre-trigger *m*) is set. If the PDB Sequence Error Interrupt Enable (SC[PDBEIE]) is set, then the sequence error interrupt is generated. A sequence error typically happens because the delay *m* is set too short and the pre-trigger *m* asserts before the previously triggered ADC conversion finishes.
- If the pre-trigger delay is 0 cycles, then both channels will flag a PDB channel sequence error and ADC will not perform a conversion.

The PDB reports PDB channel sequence errors only for pre-triggers in same PDB channel. For situations when PDB triggering is done through different PDB channels, software must ensure sufficient delays in between the pre-triggers.

When the PDB counter reaches the value (CNT + 1), the PDB Interrupt Flag (SC[PDBIF]) is set. A PDB interrupt can be generated if the PDB Sequence Error Interrupt Enable (SC[PDBEIE]) is set and the DMA Enable (SC[DMAEN]) is cleared. If the DMA Enable (SC[DMAEN]) is set, then the PDB requests a DMA transfer when the PDB Interrupt Flag (SC[PDBIF]) is set.

The modulus value in the Modulus register (MOD) is used to reset the counter back to zero at the end of the count. If the Continuous Mode Enable (SC[CONT]) is set, then the counter will then resume a new count; otherwise, the counter operation will stop until the next trigger input event occurs.

Functional description

38.5.2 PDB trigger input source selection

The PDB has up to 15 trigger input sources, namely Trigger-In 0 to Trigger-In 14. They are connected to on-chip or off-chip event sources. The PDB can be triggered by software through SC[SWTRIG].

For the trigger input sources implemented in this MCU, see chip configuration information.

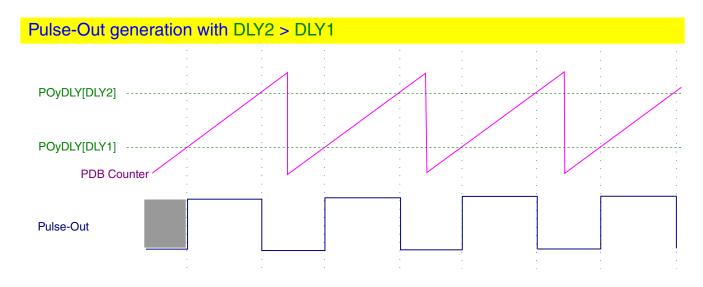
38.5.3 Pulse-Out's

PDB can generate pulse outputs of configurable width.

- When the PDB counter reaches the value set in POyDLY[DLY1], then the Pulse-Out goes high.
- When the PDB counter reaches POyDLY[DLY2], then it goes low.

POyDLY[DLY2] can be set either greater or less than POyDLY[DLY1].

ADC pre-trigger/trigger outputs and Pulse-Out generation have the same time base, because they both share the PDB counter. The pulse-out connections implemented in this MCU are described in the device's chip configuration details.



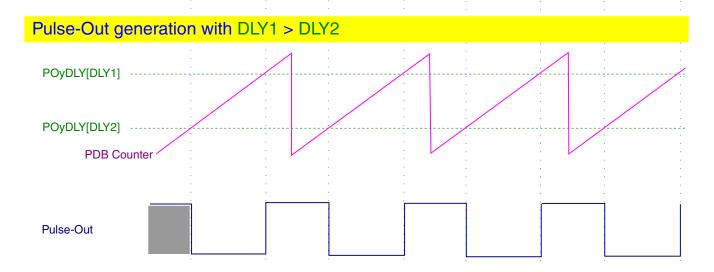


Figure 38-3. How Pulse Out is generated

38.5.4 Updating the delay registers

The following registers control the timing of the PDB operation; and in some of the applications, they may need to become effective at the same time.

- PDB Modulus register (MOD)
- PDB Interrupt Delay register (IDLY)

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018 **NXP Semiconductors** 841

Functional description

- PDB Channel *n* Delay *m* register (CH*n*DLY*m*)
- PDB Pulse-Out y Delay register (POyDLY)

The internal registers of them are buffered and any values written to them are written first to their buffers. The circumstances that cause their internal registers to be updated with the values from the buffers are summarized in the next table.

SC[LDMOD]	Update to the delay registers
00	The internal registers are loaded with the values from their buffers immediately after 1 is written to SC[LDOK].
01	The PDB counter reaches PDB_MOD[MOD] + 1 value, after 1 is written to SC[LDOK].
10	A trigger input event is detected after 1 is written to SC[LDOK].
11	Either the PDB counter reaches PDB_MOD[MOD] + 1 value or a trigger input event is detected, after 1 is written to SCII DOKI.

Table 38-5. When delay registers are updated

After 1 is written to SC[LDOK], the buffers cannot be written until the values in buffers are loaded into their internal registers. SC[LDOK] is self-cleared when the internal registers are loaded, so the application code can read it to determine the updates to the internal registers.

The following diagrams show the cases of the internal registers being updated with SC[LDMOD] is 00 and x1.

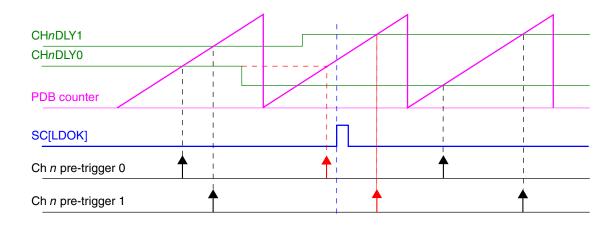


Figure 38-4. Registers update with SC[LDMOD] = 00

843

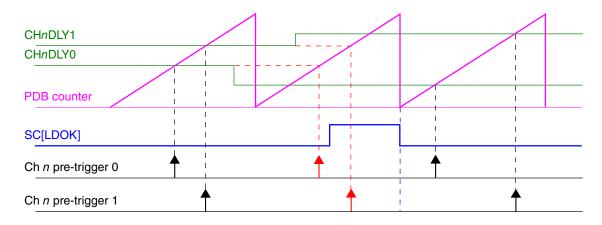


Figure 38-5. Registers update with SC[LDMOD] = x1

38.5.5 Interrupts

PDB can generate two interrupts: PDB interrupt and PDB sequence error interrupt. The following table summarizes the interrupts.

Table 38-6. PDB interrupt summary

Interrupt	Flags	Enable bit
PDB Interrupt	SC[PDBIF]	SC[PDBIE] = 1 and SC[DMAEN] = 0
PDB Sequence Error Interrupt	CHnS[ERRm]	SC[PDBEIE] = 1

38.5.6 DMA

If SC[DMAEN] is set, PDB can generate a DMA transfer request when SC[PDBIF] is set. When DMA is enabled, the PDB interrupt is not issued.

38.6 Application information

Usage Guide

38.6.1 Impact of using the prescaler and multiplication factor on timing resolution

Use of prescaler and multiplication factor greater than 1 limits the count/delay accuracy in terms of peripheral clock cycles (to the modulus of the prescaler X multiplication factor). If the multiplication factor is set to 1 and the prescaler is set to 2 then the only values of total peripheral clocks that can be detected are even values; if prescaler is set to 4 then the only values of total peripheral clocks that can be decoded as detected are mod(4) and so forth. If the applications need a really long delay value and use a prescaler set to 128, then the resolution would be limited to 128 peripheral clock cycles.

Therefore, use the lowest possible prescaler and multiplication factor for a given application.

38.7 Usage Guide

38.7.1 Using PDB to precisely control ADC conversion

For detailed information, see the ADC trigger sections in the ADC chapter.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Chapter 39 FlexTimer Module (FTM)

39.1 Chip-specific information for this module

39.1.1 Instantiation Information

This device contains three FlexTimer modules.

The following table shows how these modules are configured.

Table 39-1. FTM Instantiations

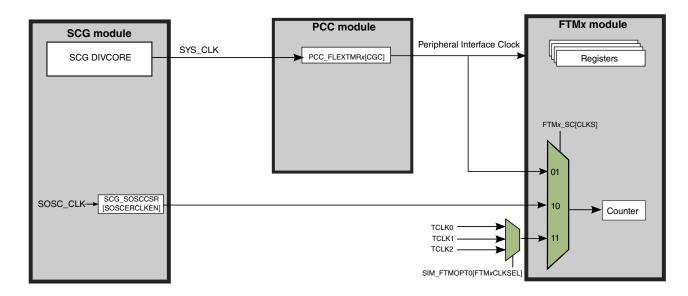
FTM instance	Number of channels	Features/usage
FTM0	8	FTM enhanced features, GTB_EN
FTM1	4	FTM enhanced features, GTB_EN, Qua drature Decoder
FTM2	4	FTM enhanced features, GTB_EN, Qua drature Decoder

Compared with the FTM0 configuration, the FTM1 and FTM2 configuration adds the Quadrature decoder feature.

39.1.2 FTM Clocking Information

The following figure shows the input clock sources available for this module.

Peripheral Clocking - FTM



NOTE

Due to FTM hardware implementation limitations, the frequency of the fixed frequency clock must not exceed 1/2 of the FTM system clock frequency (SYS_CLK).

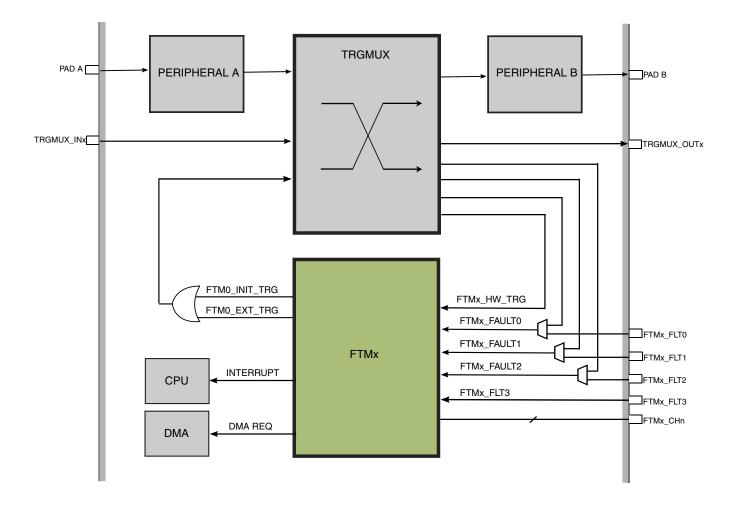
NOTE

The external clock are synchronized by FTM system clock (SYS_CLK). Therefore, to meet Nyquist criteria considering also jitter, the frequency of the external clock source must not exceed 1/4 of the system clock frequency.

39.1.3 Inter-connectivity Information

The FTM inter-connectivity is shown in the following diagram.

847



NOTE

The diagram only shows some possible fault input sources. For the actual connections of each FTM, see FTM Fault Detection Inputs for details.

39.1.3.1 FTM Fault Detection Inputs

The following fault detection input options for the FTM modules are selected via the SIM_FTMOPT0 register. The external pin option is selected by default.

- FTM0 FAULT0 = FTM0_FLT0 pin or TRGMUX output
- FTM0 FAULT1 = FTM0_FLT1 pin or TRGMUX output
- FTM0 FAULT2 = FTM0_FLT2 pin or TRGMUX output
- FTM0 FAULT3 = FTM0_FLT3 pin
- FTM1 FAULT0 = TRGMUX output
- FTM1 FAULT1 = TRGMUX output

Chip-specific information for this module

- FTM1 FAULT2 = FTM1 FLT2 pin
- FTM1 FAULT3 = FTM1_FLT3 pin
- FTM2 FAULT0 = TRGMUX output
- FTM2 FAULT1 = TRGMUX output
- FTM2 FAULT2 = FTM2_FLT2 pin
- FTM2 FAULT3 = FTM2_FLT3 pin

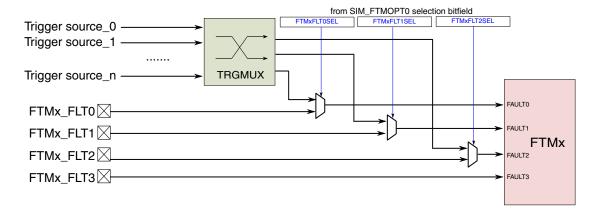


Figure 39-1. FTM0 Fault Detection Inputs

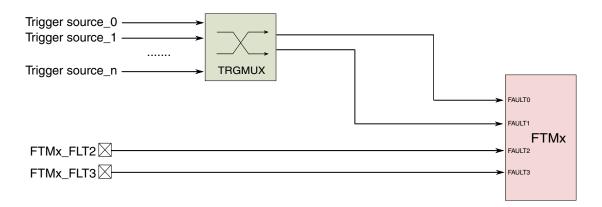


Figure 39-2. FTM1, FTM2 Fault Detection Inputs

39.1.3.2 FTM Hardware Triggers and Synchronization

The FlexTimer support external hardware trigger input which can be used for timer dynamic synchronization between multiple FlexTimers or counter reset. The FlexTimer hardware trigger are implemented as following.

FTM0:

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

- FTM0 hardware trigger 0 = TRGMUX trigger output
- FTM0 hardware trigger 1 = SIM_FTMOPT1[FTM0SYNCBIT]
- FTM0 hardware trigger 2 = FTM0_FLT0 pin

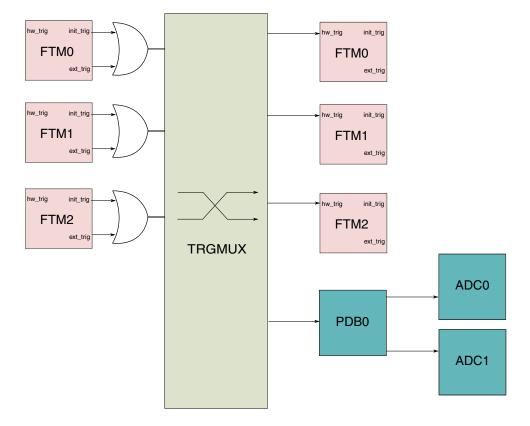
FTM1:

- FTM1 hardware trigger 0 = TRGMUX trigger output
- FTM1 hardware trigger 1 = SIM_FTMOPT1[FTM1SYNCBIT]

FTM2:

- FTM2 hardware trigger 0 = TRGMUX trigger output
- FTM2 hardware trigger 1 = SIM_FTMOPT1[FTM2SYNCBIT]

The hardware trigger source can be from many other modules via TRGMUX, like LPIT, Low Power Timer, CMP, etc. It also supports FlexTimer's self trigger outputs, ex: counter initization trigger (init_trig) and channel match trigger (ext_trig), through the flexible TRGMUX module.



Introduction

The FlexTimer trigger outputs are also usually used as trigger source by other modules, for example, the above diagram shows a case of triggering PDB and ADC. See "Chipspecific Information" in PDB chapter and ADC Trigger Sources in ADC chapter for details.

39.1.3.3 FTM Input Capture Options

The following channel 0 input capture source options are selected via SIM_FTMOPT1. The external pin option is selected by default.

- FTM1 channel 0 input capture = FTM1_CH0 pin or CMP0 output or CMP1 output
- FTM2 channel 0 input capture = FTM2_CH0 pin or CMP0 output or CMP1 output
- FTM2 channel 1 input capture = FTM2_CH1 pin or exclusive OR of FTM2_CH0, FTM2_CH1, and FTM1_CH1. See FTM Hall sensor support.

39.2 Introduction

NOTE

The number of channels supported can vary for each instance of the FTM module on a chip. See the chip-specific FTM information to see how many channels are supported for each module instance. For example, if a module instance supports only six channels, references to channel numbers 6 and 7 do not apply for that instance.

The FlexTimer module (FTM) is a two-to-eight channel timer that supports input capture, output compare, and the generation of PWM signals to control electric motor and power management applications. The FTM time reference is a 16-bit counter that can be used as an unsigned or signed counter.

39.2.1 FlexTimer philosophy

The FlexTimer is built upon a simple timer, the Timer PWM Module – TPM, used for many years on our HCS08 family of 8-bit microcontrollers. The FlexTimer extends the functionality to meet the demands of motor control, digital lighting solutions, and power conversion, while providing low cost and backwards compatibility with the TPM module.

Several key enhancements are made:

• Signed up counter

- Deadtime insertion hardware
- Fault control inputs
- Enhanced triggering functionality
- Initialization and polarity control

All of the features common with the TPM have fully backwards compatible register assignments. The FlexTimer can also use code on the same core platform without change to perform the same functions.

Motor control and power conversion features have been added through a dedicated set of registers and defaults turn off all new features. The new features, such as hardware deadtime insertion, polarity, fault control, and output forcing and masking, greatly reduce loading on the execution software and are usually each controlled by a group of registers.

FlexTimer input triggers can be from comparators, ADC, or other submodules to initiate timer functions automatically. These triggers can be linked in a variety of ways during integration of the sub modules so please note the options available for used FlexTimer configuration.

More than one FlexTimers may be synchronized to provide a larger timer with their counters incrementing in unison, assuming the initialization, the input clocks, the initial and final counting values are the same in each FlexTimer.

All main user access registers are buffered to ease the load on the executing software. A number of trigger options exist to determine which registers are updated with this user defined data.

39.2.2 Features

The FTM features include:

- FTM source clock is selectable
 - Source clock can be the FTM input clock, the fixed frequency clock, or an external clock
 - Fixed frequency clock is an additional clock input to allow the selection of an on chip clock source other than the FTM input clock
 - Selecting external clock connects FTM clock to a chip level input pin therefore allowing to synchronize the FTM counter with an off chip clock source
- Prescaler divide-by 1, 2, 4, 8, 16, 32, 64, or 128
- 16-bit counter

Introduction

- It can be a free-running counter or a counter with initial and final value
- The counting can be up or up-down
- Each channel can be configured for input capture, output compare, or edge-aligned PWM mode
- In Input Capture mode:
 - The capture can occur on rising edges, falling edges or both edges
 - An input filter can be selected for some channels.
- In Output Compare mode the output signal can be set, cleared, or toggled on match
- All channels can be configured for center-aligned PWM mode
- Each pair of channels can be combined to generate a PWM signal with independent control of both edges of PWM signal
- The FTM channels can operate as pairs with equal outputs, pairs with complementary outputs, or independent channels with independent outputs
- The deadtime insertion is available for each complementary pair
- Generation of match triggers
- Software control of PWM outputs
- Up to 4 fault inputs for global fault control
- The polarity of each channel is configurable
- The generation of an interrupt per channel
- The generation of an interrupt when the counter overflows
- The generation of an interrupt when the fault condition is detected
- The generation of an interrupt when a register reload point occurs
- Synchronized loading of write buffered FTM registers
- Half cycle and Full cycle register reload capacity
- Write protection for critical registers
- Backwards compatible with TPM
- Testing of input capture mode
- Direct access to input pin states

853

- Dual edge capture for pulse and period width measurement
- Quadrature decoder with input filters, relative position counting, and interrupt on position count or capture of position count on external event
- The FTM channels can be selected to generate a trigger pulse on channel output instead of a PWM
- Dithering capability to simulate fine edge control for both PWM period or PWM duty cycle

39.2.3 Modes of operation

When the chip is in an active Debug mode, the FTM temporarily suspends all counting until the chip returns to normal user operating mode. During Stop mode, all FTM input clocks are stopped, so the FTM is effectively disabled until clocks resume. During Wait mode, the FTM continues to operate normally. If the FTM does not need to produce a real time reference or provide the interrupt sources needed to wake the chip from Wait mode, the power can then be saved by disabling FTM functions before entering Wait mode.

39.2.4 Block Diagram

The FTM uses one input/output (I/O) pin per channel, CHn (FTM channel (n)) where n is the channel number (0–7).

NOTE

The number of channels supported can vary for each instance of the FTM module on a chip. See the chip-specific FTM information to see how many channels are supported for each module instance. For example, if a module instance supports only six channels, references to channel numbers 6 and 7 do not apply for that instance.

The following figure shows the FTM structure. The central component of the FTM is the 16-bit counter with programmable initial and final values and its counting can be up or up-down.

Introduction

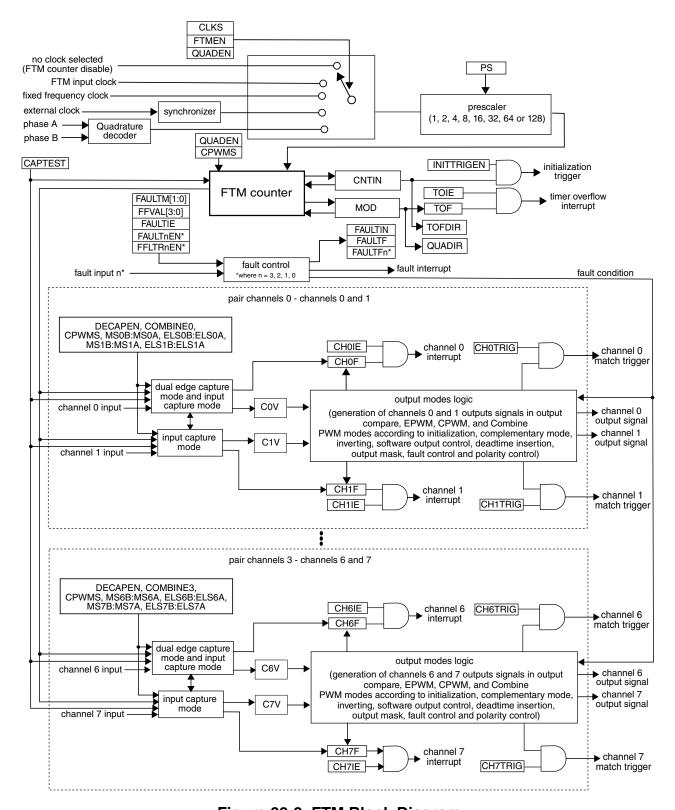


Figure 39-3. FTM Block Diagram

39.3 FTM signal descriptions

Table 39-2 shows the user-accessible signals for the FTM.

Table 39-2. FTM signal descriptions

Signal	Description	I/O	Function
EXTCLK	External clock. FTM external clock can be selected to drive the FTM counter.	I	The external clock input signal is used as the FTM counter clock if selected by CLKS[1:0] bits in the SC register. This clock signal must not exceed 1/4 of FTM input clock frequency. The FTM counter prescaler selection and settings are also used when an external clock is selected.
CHn	FTM channel (n), where n can be 7-0	I/O	Each FTM channel can be configured to operate either as input or output. The direction associated with each channel, input or output, is selected according to the mode assigned for that channel.
FAULTj	Fault input (j), where j can be 3-0	I	The fault input signals are used to control the CHn channel output state. If a fault is detected, the FAULTj signal is asserted and the channel output is put in a safe state. The behavior of the fault logic is defined by the FAULTM[1:0] control bits in the MODE register and FAULTEN bit in the COMBINE register. Note that each FAULTj input may affect all channels selectively since FAULTM[1:0] and FAULTEN control bits are defined for each pair of channels. Because there are several FAULTj inputs, maximum of 4 for the FTM module, each one of these inputs is activated by the FAULTjEN bit in the FLTCTRL register.
PHA	Quadrature decoder phase A input. Input pin associated with quadrature decoder phase A.	I	The quadrature decoder phase A input is used as the Quadrature Decoder mode is selected. The phase A input signal is one of the signals that control the FTM counter increment or decrement in the Quadrature Decoder mode.
РНВ	Quadrature decoder phase B input. Input pin associated with quadrature decoder phase B.	I	The quadrature decoder phase B input is used as the Quadrature Decoder mode is selected. The phase B input signal is one of the signals that control the FTM counter increment or decrement in the Quadrature Decoder mode.

39.4 Memory map and register definition

39.4.1 Memory map

This section presents a high-level summary of the FTM registers and how they are mapped.

The registers and bits of an unavailable function in the FTM remain in the memory map and in the reset value, but they have no active function.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

NOTE

The number of channels supported can vary for each instance of the FTM module on a chip. See the chip-specific FTM information to see how many channels are supported for each module instance. For example, if a module instance supports only six channels, references to channel numbers 6 and 7 do not apply for that instance.

Note

Do not write in the region from the CNTIN register through the PWMLOAD register when FTMEN = 0.

39.4.2 Register descriptions

Accesses to reserved addresses result in transfer errors. Registers for absent channels are considered reserved. Double buffered register writes must be done using 32-bit operations.

FTM memory map

Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page
4003_8000	Status And Control (FTM0_SC)	32	R/W	0000_0000h	39.4.3/862
4003_8004	Counter (FTM0_CNT)	32	R/W	0000_0000h	39.4.4/865
4003_8008	Modulo (FTM0_MOD)	32	R/W	0000_0000h	39.4.5/865
4003_800C	Channel (n) Status And Control (FTM0_C0SC)	32	R/W	0000_0000h	39.4.6/867
4003_8010	Channel (n) Value (FTM0_C0V)	32	R/W	0000_0000h	39.4.7/869
4003_8014	Channel (n) Status And Control (FTM0_C1SC)	32	R/W	0000_0000h	39.4.6/867
4003_8018	Channel (n) Value (FTM0_C1V)	32	R/W	0000_0000h	39.4.7/869
4003_801C	Channel (n) Status And Control (FTM0_C2SC)	32	R/W	0000_0000h	39.4.6/867
4003_8020	Channel (n) Value (FTM0_C2V)	32	R/W	0000_0000h	39.4.7/869
4003_8024	Channel (n) Status And Control (FTM0_C3SC)	32	R/W	0000_0000h	39.4.6/867
4003_8028	Channel (n) Value (FTM0_C3V)	32	R/W	0000_0000h	39.4.7/869
4003_802C	Channel (n) Status And Control (FTM0_C4SC)	32	R/W	0000_0000h	39.4.6/867
4003_8030	Channel (n) Value (FTM0_C4V)	32	R/W	0000_0000h	39.4.7/869
4003_8034	Channel (n) Status And Control (FTM0_C5SC)	32	R/W	0000_0000h	39.4.6/867
4003_8038	Channel (n) Value (FTM0_C5V)	32	R/W	0000_0000h	39.4.7/869
4003_803C	Channel (n) Status And Control (FTM0_C6SC)	32	R/W	0000_0000h	39.4.6/867
4003_8040	Channel (n) Value (FTM0_C6V)	32	R/W	0000_0000h	39.4.7/869
4003_8044	Channel (n) Status And Control (FTM0_C7SC)	32	R/W	0000_0000h	39.4.6/867
4003_8048	Channel (n) Value (FTM0_C7V)	32	R/W	0000_0000h	39.4.7/869

Table continues on the next page...

FTM memory map (continued)

Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page
4003_804C	Counter Initial Value (FTM0_CNTIN)	32	R/W	0000_0000h	39.4.8/869
4003_8050	Capture And Compare Status (FTM0_STATUS)	32	R/W	0000_0000h	39.4.9/870
4003_8054	Features Mode Selection (FTM0_MODE)	32	R/W	0000_0004h	39.4.10/ 872
4003_8058	Synchronization (FTM0_SYNC)	32	R/W	0000_0000h	39.4.11/ 874
4003_805C	Initial State For Channels Output (FTM0_OUTINIT)	32	R/W	0000_0000h	39.4.12/ 876
4003_8060	Output Mask (FTM0_OUTMASK)	32	R/W	0000_0000h	39.4.13/ 878
4003_8064	Function For Linked Channels (FTM0_COMBINE)	32	R/W	0000_0000h	39.4.14/ 880
4003_8068	Deadtime Configuration (FTM0_DEADTIME)	32	R/W	0000_0000h	39.4.15/ 884
4003_806C	FTM External Trigger (FTM0_EXTTRIG)	32	R/W	0000_0000h	39.4.16/ 885
4003_8070	Channels Polarity (FTM0_POL)	32	R/W	0000_0000h	39.4.17/ 887
4003_8074	Fault Mode Status (FTM0_FMS)	32	R/W	0000_0000h	39.4.18/ 890
4003_8078	Input Capture Filter Control (FTM0_FILTER)	32	R/W	0000_0000h	39.4.19/ 892
4003_807C	Fault Control (FTM0_FLTCTRL)	32	R/W	0000_0000h	39.4.20/ 893
4003_8080	Quadrature Decoder Control And Status (FTM0_QDCTRL)	32	R/W	0000_0000h	39.4.21/ 896
4003_8084	Configuration (FTM0_CONF)	32	R/W	0000_0000h	39.4.22/ 898
4003_8088	FTM Fault Input Polarity (FTM0_FLTPOL)	32	R/W	0000_0000h	39.4.23/ 899
4003_808C	Synchronization Configuration (FTM0_SYNCONF)	32	R/W	0000_0000h	39.4.24/ 900
4003_8090	FTM Inverting Control (FTM0_INVCTRL)	32	R/W	0000_0000h	39.4.25/ 902
4003_8094	FTM Software Output Control (FTM0_SWOCTRL)	32	R/W	0000_0000h	39.4.26/ 903
4003_8098	FTM PWM Load (FTM0_PWMLOAD)	32	R/W	0000_0000h	39.4.27/ 906
4003_809C	Half Cycle Register (FTM0_HCR)	32	R/W	0000_0000h	39.4.28/ 908
4003_8200	Mirror of Modulo Value (FTM0_MOD_MIRROR)	32	R/W	0000_0000h	39.4.29/ 908
4003_8204	Mirror of Channel (n) Match Value (FTM0_C0V_MIRROR)	32	R/W	0000_0000h	39.4.30/ 909

Table continues on the next page...

Memory map and register definition

FTM memory map (continued)

Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page
4003_8208	Mirror of Channel (n) Match Value (FTM0_C1V_MIRROR)	32	R/W	0000_0000h	39.4.30/ 909
4003_820C	Mirror of Channel (n) Match Value (FTM0_C2V_MIRROR)	32	R/W	0000_0000h	39.4.30/ 909
4003_8210	Mirror of Channel (n) Match Value (FTM0_C3V_MIRROR)	32	R/W	0000_0000h	39.4.30/ 909
4003_8214	Mirror of Channel (n) Match Value (FTM0_C4V_MIRROR)	32	R/W	0000_0000h	39.4.30/ 909
4003_8218	Mirror of Channel (n) Match Value (FTM0_C5V_MIRROR)	32	R/W	0000_0000h	39.4.30/ 909
4003_821C	Mirror of Channel (n) Match Value (FTM0_C6V_MIRROR)	32	R/W	0000_0000h	39.4.30/ 909
4003_8220	Mirror of Channel (n) Match Value (FTM0_C7V_MIRROR)	32	R/W	0000_0000h	39.4.30/ 909
4003_9000	Status And Control (FTM1_SC)	32	R/W	0000_0000h	39.4.3/862
4003_9004	Counter (FTM1_CNT)	32	R/W	0000_0000h	39.4.4/865
4003_9008	Modulo (FTM1_MOD)	32	R/W	0000_0000h	39.4.5/865
4003_900C	Channel (n) Status And Control (FTM1_C0SC)	32	R/W	0000_0000h	39.4.6/867
4003_9010	Channel (n) Value (FTM1_C0V)	32	R/W	0000_0000h	39.4.7/869
4003_9014	Channel (n) Status And Control (FTM1_C1SC)	32	R/W	0000_0000h	39.4.6/867
4003_9018	Channel (n) Value (FTM1_C1V)	32	R/W	0000_0000h	39.4.7/869
4003_901C	Channel (n) Status And Control (FTM1_C2SC)	32	R/W	0000_0000h	39.4.6/867
4003_9020	Channel (n) Value (FTM1_C2V)	32	R/W	0000_0000h	39.4.7/869
4003_9024	Channel (n) Status And Control (FTM1_C3SC)	32	R/W	0000_0000h	39.4.6/867
4003_9028	Channel (n) Value (FTM1_C3V)	32	R/W	0000_0000h	39.4.7/869
4003_902C	Channel (n) Status And Control (FTM1_C4SC)	32	R/W	0000_0000h	39.4.6/867
4003_9030	Channel (n) Value (FTM1_C4V)	32	R/W	0000_0000h	39.4.7/869
4003_9034	Channel (n) Status And Control (FTM1_C5SC)	32	R/W	0000_0000h	39.4.6/867
4003_9038	Channel (n) Value (FTM1_C5V)	32	R/W	0000_0000h	39.4.7/869
4003_903C	Channel (n) Status And Control (FTM1_C6SC)	32	R/W	0000_0000h	39.4.6/867
4003_9040	Channel (n) Value (FTM1_C6V)	32	R/W	0000_0000h	39.4.7/869
4003_9044	Channel (n) Status And Control (FTM1_C7SC)	32	R/W	0000_0000h	39.4.6/867
4003_9048	Channel (n) Value (FTM1_C7V)	32	R/W	0000_0000h	39.4.7/869
4003_904C	Counter Initial Value (FTM1_CNTIN)	32	R/W	0000_0000h	39.4.8/869
4003_9050	Capture And Compare Status (FTM1_STATUS)	32	R/W	0000_0000h	39.4.9/870
4003_9054	Features Mode Selection (FTM1_MODE)	32	R/W	0000_0004h	39.4.10/ 872
4003_9058	Synchronization (FTM1_SYNC)	32	R/W	0000_0000h	39.4.11/ 874
4003_905C	Initial State For Channels Output (FTM1_OUTINIT)	32	R/W	0000_0000h	39.4.12/ 876

Table continues on the next page...

FTM memory map (continued)

Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page
4003_9060	Output Mask (FTM1_OUTMASK)	32	R/W	0000_0000h	39.4.13/ 878
4003_9064	Function For Linked Channels (FTM1_COMBINE)	32	R/W	0000_0000h	39.4.14/ 880
4003_9068	Deadtime Configuration (FTM1_DEADTIME)	32	R/W	0000_0000h	39.4.15/ 884
4003_906C	FTM External Trigger (FTM1_EXTTRIG)	32	R/W	0000_0000h	39.4.16/ 885
4003_9070	Channels Polarity (FTM1_POL)	32	R/W	0000_0000h	39.4.17/ 887
4003_9074	Fault Mode Status (FTM1_FMS)	32	R/W	0000_0000h	39.4.18/ 890
4003_9078	Input Capture Filter Control (FTM1_FILTER)	32	R/W	0000_0000h	39.4.19/ 892
4003_907C	Fault Control (FTM1_FLTCTRL)	32	R/W	0000_0000h	39.4.20/ 893
4003_9080	Quadrature Decoder Control And Status (FTM1_QDCTRL)	32	R/W	0000_0000h	39.4.21/ 896
4003_9084	Configuration (FTM1_CONF)	32	R/W	0000_0000h	39.4.22/ 898
4003_9088	FTM Fault Input Polarity (FTM1_FLTPOL)	32	R/W	0000_0000h	39.4.23/ 899
4003_908C	Synchronization Configuration (FTM1_SYNCONF)	32	R/W	0000_0000h	39.4.24/ 900
4003_9090	FTM Inverting Control (FTM1_INVCTRL)	32	R/W	0000_0000h	39.4.25/ 902
4003_9094	FTM Software Output Control (FTM1_SWOCTRL)	32	R/W	0000_0000h	39.4.26/ 903
4003_9098	FTM PWM Load (FTM1_PWMLOAD)	32	R/W	0000_0000h	39.4.27/ 906
4003_909C	Half Cycle Register (FTM1_HCR)	32	R/W	0000_0000h	39.4.28/ 908
4003_9200	Mirror of Modulo Value (FTM1_MOD_MIRROR)	32	R/W	0000_0000h	39.4.29/ 908
4003_9204	Mirror of Channel (n) Match Value (FTM1_C0V_MIRROR)	32	R/W	0000_0000h	39.4.30/ 909
4003_9208	Mirror of Channel (n) Match Value (FTM1_C1V_MIRROR)	32	R/W	0000_0000h	39.4.30/ 909
4003_920C	Mirror of Channel (n) Match Value (FTM1_C2V_MIRROR)	32	R/W	0000_0000h	39.4.30/ 909
4003_9210	Mirror of Channel (n) Match Value (FTM1_C3V_MIRROR)	32	R/W	0000_0000h	39.4.30/ 909
4003_9214	Mirror of Channel (n) Match Value (FTM1_C4V_MIRROR)	32	R/W	0000_0000h	39.4.30/ 909

Table continues on the next page...

Memory map and register definition

FTM memory map (continued)

Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page
4003_9218	Mirror of Channel (n) Match Value (FTM1_C5V_MIRROR)	32	R/W	0000_0000h	39.4.30/ 909
4003_921C	Mirror of Channel (n) Match Value (FTM1_C6V_MIRROR)	32	R/W	0000_0000h	39.4.30/ 909
4003_9220	Mirror of Channel (n) Match Value (FTM1_C7V_MIRROR)	32	R/W	0000_0000h	39.4.30/ 909
4003_A000	Status And Control (FTM2_SC)	32	R/W	0000_0000h	39.4.3/862
4003_A004	Counter (FTM2_CNT)	32	R/W	0000_0000h	39.4.4/865
4003_A008	Modulo (FTM2_MOD)	32	R/W	0000_0000h	39.4.5/865
4003_A00C	Channel (n) Status And Control (FTM2_C0SC)	32	R/W	0000_0000h	39.4.6/867
4003_A010	Channel (n) Value (FTM2_C0V)	32	R/W	0000_0000h	39.4.7/869
4003_A014	Channel (n) Status And Control (FTM2_C1SC)	32	R/W	0000_0000h	39.4.6/867
4003_A018	Channel (n) Value (FTM2_C1V)	32	R/W	0000_0000h	39.4.7/869
4003_A01C	Channel (n) Status And Control (FTM2_C2SC)	32	R/W	0000_0000h	39.4.6/867
4003_A020	Channel (n) Value (FTM2_C2V)	32	R/W	0000_0000h	39.4.7/869
4003_A024	Channel (n) Status And Control (FTM2_C3SC)	32	R/W	0000_0000h	39.4.6/867
4003_A028	Channel (n) Value (FTM2_C3V)	32	R/W	0000_0000h	39.4.7/869
4003_A02C	Channel (n) Status And Control (FTM2_C4SC)	32	R/W	0000_0000h	39.4.6/867
4003_A030	Channel (n) Value (FTM2_C4V)	32	R/W	0000_0000h	39.4.7/869
4003_A034	Channel (n) Status And Control (FTM2_C5SC)	32	R/W	0000_0000h	39.4.6/867
4003_A038	Channel (n) Value (FTM2_C5V)	32	R/W	0000_0000h	39.4.7/869
4003_A03C	Channel (n) Status And Control (FTM2_C6SC)	32	R/W	0000_0000h	39.4.6/867
4003_A040	Channel (n) Value (FTM2_C6V)	32	R/W	0000_0000h	39.4.7/869
4003_A044	Channel (n) Status And Control (FTM2_C7SC)	32	R/W	0000_0000h	39.4.6/867
4003_A048	Channel (n) Value (FTM2_C7V)	32	R/W	0000_0000h	39.4.7/869
4003_A04C	Counter Initial Value (FTM2_CNTIN)	32	R/W	0000_0000h	39.4.8/869
4003_A050	Capture And Compare Status (FTM2_STATUS)	32	R/W	0000_0000h	39.4.9/870
4003_A054	Features Mode Selection (FTM2_MODE)	32	R/W	0000_0004h	39.4.10/ 872
4003_A058	Synchronization (FTM2_SYNC)	32	R/W	0000_0000h	39.4.11/ 874
4003_A05C	Initial State For Channels Output (FTM2_OUTINIT)	32	R/W	0000_0000h	39.4.12/ 876
4003_A060	Output Mask (FTM2_OUTMASK)	32	R/W	0000_0000h	39.4.13/ 878
4003_A064	Function For Linked Channels (FTM2_COMBINE)	32	R/W	0000_0000h	39.4.14/ 880
4003_A068	Deadtime Configuration (FTM2_DEADTIME)	32	R/W	0000_0000h	39.4.15/ 884
4003_A06C	FTM External Trigger (FTM2_EXTTRIG)	32	R/W	0000_0000h	39.4.16/ 885

Table continues on the next page...

FTM memory map (continued)

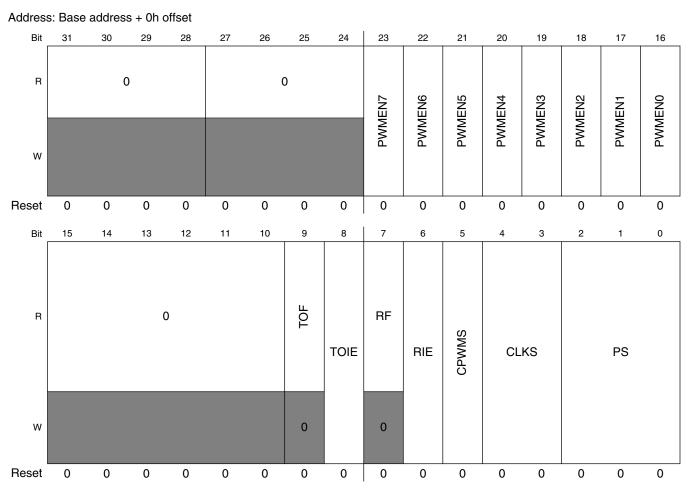
Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page
4003_A070	Channels Polarity (FTM2_POL)	32	R/W	0000_0000h	39.4.17/ 887
4003_A074	Fault Mode Status (FTM2_FMS)	32	R/W	0000_0000h	39.4.18/ 890
4003_A078	Input Capture Filter Control (FTM2_FILTER)	32	R/W	0000_0000h	39.4.19/ 892
4003_A07C	Fault Control (FTM2_FLTCTRL)	32	R/W	0000_0000h	39.4.20/ 893
4003_A080	Quadrature Decoder Control And Status (FTM2_QDCTRL)	32	R/W	0000_0000h	39.4.21/ 896
4003_A084	Configuration (FTM2_CONF)	32	R/W	0000_0000h	39.4.22/ 898
4003_A088	FTM Fault Input Polarity (FTM2_FLTPOL)	32	R/W	0000_0000h	39.4.23/ 899
4003_A08C	Synchronization Configuration (FTM2_SYNCONF)	32	R/W	0000_0000h	39.4.24/ 900
4003_A090	FTM Inverting Control (FTM2_INVCTRL)	32	R/W	0000_0000h	39.4.25/ 902
4003_A094	FTM Software Output Control (FTM2_SWOCTRL)	32	R/W	0000_0000h	39.4.26/ 903
4003_A098	FTM PWM Load (FTM2_PWMLOAD)	32	R/W	0000_0000h	39.4.27/ 906
4003_A09C	Half Cycle Register (FTM2_HCR)	32	R/W	0000_0000h	39.4.28/ 908
4003_A200	Mirror of Modulo Value (FTM2_MOD_MIRROR)	32	R/W	0000_0000h	39.4.29/ 908
4003_A204	Mirror of Channel (n) Match Value (FTM2_C0V_MIRROR)	32	R/W	0000_0000h	39.4.30/ 909
4003_A208	Mirror of Channel (n) Match Value (FTM2_C1V_MIRROR)	32	R/W	0000_0000h	39.4.30/ 909
4003_A20C	Mirror of Channel (n) Match Value (FTM2_C2V_MIRROR)	32	R/W	0000_0000h	39.4.30/ 909
4003_A210	Mirror of Channel (n) Match Value (FTM2_C3V_MIRROR)	32	R/W	0000_0000h	39.4.30/ 909
4003_A214	Mirror of Channel (n) Match Value (FTM2_C4V_MIRROR)	32	R/W	0000_0000h	39.4.30/ 909
4003_A218	Mirror of Channel (n) Match Value (FTM2_C5V_MIRROR)	32	R/W	0000_0000h	39.4.30/ 909
4003_A21C	Mirror of Channel (n) Match Value (FTM2_C6V_MIRROR)	32	R/W	0000_0000h	39.4.30/ 909
4003_A220	Mirror of Channel (n) Match Value (FTM2_C7V_MIRROR)	32	R/W	0000_0000h	39.4.30/ 909

39.4.3 Status And Control (FTMx_SC)

SC contains the overflow status flag and control bits used to configure the interrupt enable, FTM configuration, clock source, and prescaler factor.

This register also contains the output enable control bits and the reload opportunity flag control.

These controls relate to all channels within this module.



FTMx_SC field descriptions

Field	Description
31–28 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
27–24 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
23 PWMEN7	Channel 7 PWM enable bit

Table continues on the next page...

FTMx_SC field descriptions (continued)

Field	Description
	This bit enables the PWM channel output. This bit should be set to 0 (output disabled) when an input
	mode is used.
	0 Channel output port is disabled
	1 Channel output port is enabled
22 PWMEN6	Channel 6 PWM enable bit
	This bit enables the PWM channel output. This bit should be set to 0 (output disabled) when an input mode is used.
	0 Channel output port is disabled
	1 Channel output port is enabled
21 PWMEN5	Channel 5 PWM enable bit
	This bit enables the PWM channel output. This bit should be set to 0 (output disabled) when an input mode is used.
	0 Channel output port is disabled
	1 Channel output port is enabled
20 PWMEN4	Channel 4 PWM enable bit
	This bit enables the PWM channel output. This bit should be set to 0 (output disabled) when an input mode is used.
	0 Channel output port is disabled
	1 Channel output port is enabled
19	Channel 3 PWM enable bit
PWMEN3	This bit enables the PWM channel output. This bit should be set to 0 (output disabled) when an input mode is used.
	0 Channel output port is disabled
	1 Channel output port is enabled
18	Channel 2 PWM enable bit
PWMEN2	This bit enables the PWM channel output. This bit should be set to 0 (output disabled) when an input mode is used.
	0 Channel output port is disabled
	1 Channel output port is enabled
17 PWMEN1	Channel 1 PWM enable bit
	This bit enables the PWM channel output. This bit should be set to 0 (output disabled) when an input mode is used.
	0 Channel output port is disabled
	1 Channel output port is enabled
16 PWMEN0	Channel 0 PWM enable bit
	This bit enables the PWM channel output. This bit should be set to 0 (output disabled) when an input mode is used.
	0 Channel output port is disabled
	1 Channel output port is enabled
L	<u></u>

Table continues on the next page...

Memory map and register definition

FTMx_SC field descriptions (continued)

Field	Description
15–10	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
9 TOF	Timer Overflow Flag
	Set by hardware when the FTM counter passes the value in the MOD register. The TOF bit is cleared by reading the SC register while TOF is set and then writing a 0 to TOF bit. Writing a 1 to TOF has no effect.
	If another FTM overflow occurs between the read and write operations, the write operation has no effect; therefore, TOF remains set indicating an overflow has occurred. In this case, a TOF interrupt request is not lost due to the clearing sequence for a previous TOF.
	0 FTM counter has not overflowed.
	1 FTM counter has overflowed.
8 TOIE	Timer Overflow Interrupt Enable
	Enables FTM overflow interrupts.
	0 Disable TOF interrupts. Use software polling.
	1 Enable TOF interrupts. An interrupt is generated when TOF equals one.
7 RF	Reload Flag
	Set by hardware when FTM counter matches the value of a reload point configured by FTMxPWMLOAD register. The RF bit is cleared by reading the SC register while RF is set and then writing a 0 to RF bit. Writing 1 to RF has no effect.
	If another reload point is reached between the read and write operations, the write operation has no effect; therefore, RF remains set.
	0 FTM counter did not reach a reload point.
	1 FTM counter reached a reload point.
6	Reload Interrupt Enable
RIE	Enables the reload oportunity interrupt.
	0 Reload interrupt is disabled.
	1 Reload interrupt is enabled.
5 CPWMS	Center-Aligned PWM Select
	Selects CPWM mode. This mode configures the FTM to operate in Up-Down Counting mode.
	This field is write protected. It can be written only when MODE[WPDIS] = 1.
	0 FTM counter operates in Up Counting mode.
	FTM counter operates in Up Counting mode.FTM counter operates in Up-Down Counting mode.
4–3 CLKS	Clock Source Selection
	Selects one of the three FTM counter clock sources.
	This field is write protected. It can be written only when MODE[WPDIS] = 1.
	No clock selected. This in effect disables the FTM counter.FTM input clock
	10 Fixed frequency clock
	11 External clock
PS	Prescale Factor Selection

Table continues on the next page...

FTMx_SC field descriptions (continued)

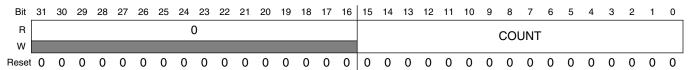
Field	Description
	Selects one of 8 division factors for the clock source selected by CLKS. The new prescaler factor affects the clock source on the next FTM input clock cycle after the new value is updated into the register bits.
	This field is write protected. It can be written only when MODE[WPDIS] = 1.
	000 Divide by 1
	001 Divide by 2
	010 Divide by 4
	011 Divide by 8
	100 Divide by 16
	101 Divide by 32
	110 Divide by 64
	111 Divide by 128

39.4.4 Counter (FTMx_CNT)

The CNT register contains the FTM counter value.

Reset clears the CNT register. Writing any value to COUNT updates the counter with its initial value, CNTIN.

Address: Base address + 4h offset



FTMx_CNT field descriptions

Field	Description
31–16 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
COUNT	Counter Value

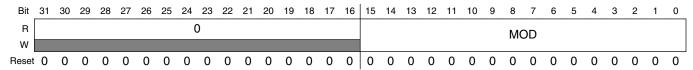
39.4.5 Modulo (FTMx_MOD)

The Modulo register contains the modulo value for the FTM counter. After the FTM counter reaches the modulo value, the overflow flag (TOF) becomes set at the next clock cycle, and the next value of FTM counter depends on the selected counting method; see Counter.

Writes to the MOD register are done on its write buffer. The MOD register is updated with its write buffer value according to Registers updated from write buffers. If FTMEN = 0, a write to SC register resets manually this write coherency mechanism.

Initialize the FTM counter, by writing to CNT, before writing to the MOD register to avoid confusion about when the first counter overflow will occur.

Address: Base address + 8h offset



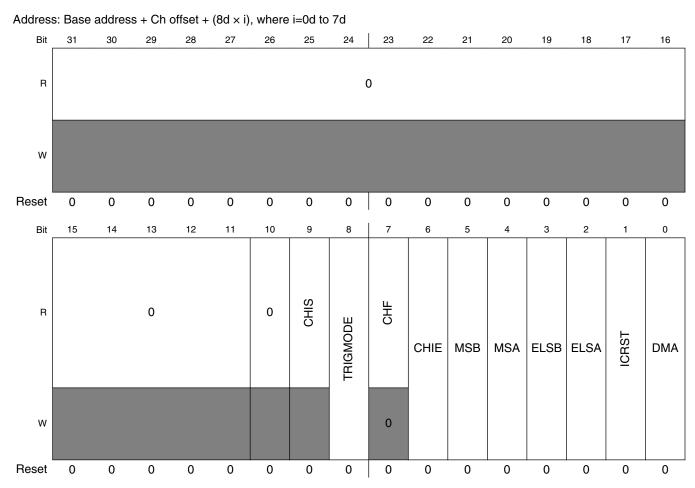
FTMx_MOD field descriptions

Field	Description
31–16 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
MOD	Modulo Value

867

39.4.6 Channel (n) Status And Control (FTMx_CnSC)

CnSC contains channel (n) status bits and control bits that select the channel (n) mode and its functionality.



FTMx_CnSC field descriptions

Field	Description
31–11 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
10 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
9 CHIS	Channel (n) Input State The CHIS bit has the value of the channel (n) input after the double-sampling or the filtering (if the channel (n) filter is enabled) both them are inside the FTM. NOTE: The CHIS bit should be ignored when the channel (n) is not in an input mode.

Table continues on the next page...

FTMx_CnSC field descriptions (continued)

Field	Description
	NOTE: When the pair channels is on dual edge mode, the channel (n+1) CHIS bit is the channel (n+1) input value and not the channel (n) input value (this signal is the input signal used by the dual edge mode).
	0 The channel (n) input is zero.
	1 The channel (n) input is one.
8	Trigger mode control
TRIGMODE	This bit controls the trigger generation on FTM channel outputs. This mode is allowed only if when FTM channel is configured to EPWM (up counting) or CPWM (up-down counting) modes. If a match in the channel occurs, a trigger pulse with one FTM clock cycle width will be generated in the channel output. See Channel trigger output for more details about trigger mode feature.
	This field is write protected. It can be written only when MODE[WPDIS] = 1.
	O Channel outputs will generate the normal PWM outputs without generating a pulse.
	1 If a match in the channel occurs, a trigger generation on channel output will happen. The trigger pulse width has one FTM clock cycle.
7	Channel (n) Flag
CHF	Set by hardware when an event occurs on the channel (n). CHF is cleared by reading the CnSC register while CHF is set and then writing a 0 to the CHF bit. Writing a 1 to CHF has no effect.
	If another event occurs between the read and write operations, the write operation has no effect; therefore, CHF remains set indicating an event has occurred. In this case a CHF interrupt request is not lost due to the clearing sequence for a previous CHF.
	0 No channel (n) event has occurred.
	1 A channel (n) event has occurred.
6	Channel (n) Interrupt Enable
CHIE	Enables channel (n) interrupt.
	0 Disable channel (n) interrupt. Use software polling.
	1 Enable channel (n) interrupt.
5	Channel (n) Mode Select
MSB	Used on the selection of the channel (n) mode. See Channel Modes.
	This field is write protected. It can be written only when MODE[WPDIS] = 1.
4	Channel (n) Mode Select
MSA	Used on the selection of the channel (n) mode. See Channel Modes.
	This field is write protected. It can be written only when MODE[WPDIS] = 1.
3 ELSB	Channel (n) Edge or Level Select
ELSB	Used on the selection of the channel (n) mode. See Channel Modes.
	This field is write protected. It can be written only when MODE[WPDIS] = 1.
2	Channel (n) Edge or Level Select
ELSA	Used on the selection of the channel (n) mode. See Channel Modes.
	This field is write protected. It can be written only when MODE[WPDIS] = 1.
	·

Table continues on the next page...

FTMx_CnSC field descriptions (continued)

Field	Description
1	FTM counter reset by the selected input capture event.
ICRST	FTM counter reset is driven by the selected event of the channel (n) in the Input Capture mode.
	This field is write protected. It can be written only when MODE[WPDIS] = 1.
	0 FTM counter is not reset when the selected channel (n) input event is detected.
	1 FTM counter is reset when the selected channel (n) input event is detected.
0	DMA Enable
DMA	Enables DMA transfers for the channel.
	0 Disable DMA transfers.
	1 Enable DMA transfers.

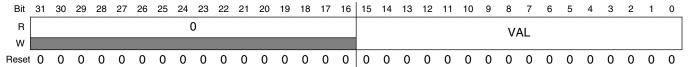
39.4.7 Channel (n) Value (FTMx_CnV)

These registers contain the captured FTM counter value for the input modes or the match value for the output modes.

In Input Capture, Capture Test, and Dual Edge Capture modes, any write to a CnV register is ignored.

In output modes, writes to the CnV register are done on its write buffer. The CnV register is updated with its write buffer value according to Registers updated from write buffers. If FTMEN = 0, a write to CnSC register resets manually this write coherency mechanism.





FTMx_CnV field descriptions

Field	Description
31–16 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
neserveu	Triis read-only neid is reserved and always has the value o.
VAL	Channel Value
	Captured FTM counter value of the input modes or the match value for the output modes

39.4.8 Counter Initial Value (FTMx_CNTIN)

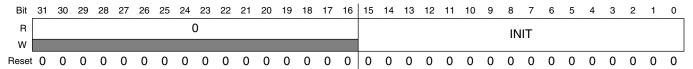
The Counter Initial Value register contains the initial value for the FTM counter.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Writing to the CNTIN register latches the value into a buffer. The CNTIN register is updated with the value of its write buffer according to Registers updated from write buffers.

When the FTM clock is initially selected, by writing a non-zero value to the CLKS bits, the FTM counter starts with the value 0x0000. To avoid this behavior, before the first write to select the FTM clock, write the new value to the the CNTIN register and then initialize the FTM counter by writing any value to the CNT register.





FTMx_CNTIN field descriptions

Field	Description
31–16 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
INIT	Initial Value Of The FTM Counter

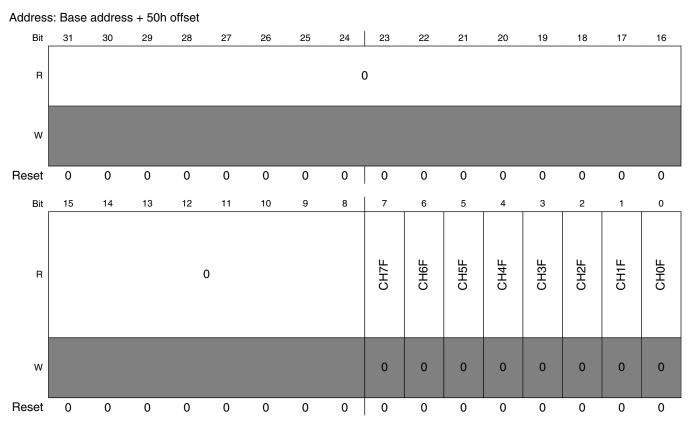
39.4.9 Capture And Compare Status (FTMx_STATUS)

The STATUS register contains a copy of the status flag CHF bit in CnSC for each FTM channel for software convenience.

Each CHF bit in STATUS is a mirror of CHF bit in CnSC. All CHF bits can be checked using only one read of STATUS. All CHF bits can be cleared by reading STATUS followed by writing 0x00 to STATUS.

Hardware sets the individual channel flags when an event occurs on the channel. CHF is cleared by reading STATUS while CHF is set and then writing a 0 to the CHF bit. Writing a 1 to CHF has no effect.

If another event occurs between the read and write operations, the write operation has no effect; therefore, CHF remains set indicating an event has occurred. In this case, a CHF interrupt request is not lost due to the clearing sequence for a previous CHF.



FTMx_STATUS field descriptions

Field	Description
31–8	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
7 CH7F	Channel 7 Flag
	See the register description.
	0 No channel event has occurred.
	1 A channel event has occurred.
6 CH6F	Channel 6 Flag
Orior	See the register description.
	0 No channel event has occurred.
	1 A channel event has occurred.
5 CH5F	Channel 5 Flag
Orior	See the register description.
	0 No channel event has occurred.
	1 A channel event has occurred.
4 CH4F	Channel 4 Flag
	See the register description.

Table continues on the next page...

FTMx_STATUS field descriptions (continued)

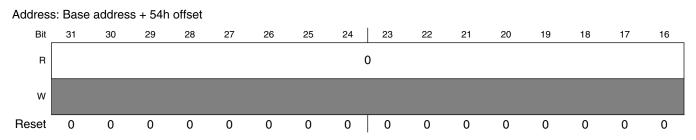
Field	Description
	0 No channel event has occurred.
	1 A channel event has occurred.
3	Channel 3 Flag
CH3F	See the register description.
	0 No channel event has occurred.
	1 A channel event has occurred.
2 CH2F	Channel 2 Flag
	See the register description.
	No channel event has occurred.
	1 A channel event has occurred.
1	Channel 1 Flag
CH1F	See the register description.
	0 No channel event has occurred.
	1 A channel event has occurred.
0 CH0F	Channel 0 Flag
	See the register description.
	0 No channel event has occurred.
	1 A channel event has occurred.

39.4.10 Features Mode Selection (FTMx_MODE)

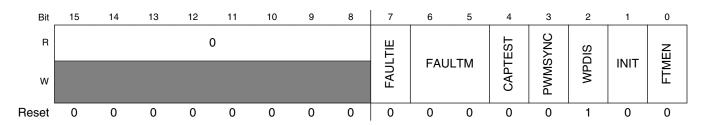
This register contains the global enable bit for FTM-specific features and the control bits used to configure:

- Fault control mode and interrupt
- Capture Test mode
- PWM synchronization
- Write protection
- Channel output initialization

These controls relate to all channels within this module.



Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018



FTMx_MODE field descriptions

Field	Description
31–8 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
7	Fault Interrupt Enable
FAULTIE	Enables the generation of an interrupt when a fault is detected by FTM and the FTM fault control is enabled.
	0 Fault control interrupt is disabled.
	1 Fault control interrupt is enabled.
6–5	Fault Control Mode
FAULTM	Defines the FTM fault control mode.
	This field is write protected. It can be written only when MODE[WPDIS] = 1.
	00 Fault control is disabled for all channels.
	Pault control is enabled for even channels only (channels 0, 2, 4, and 6), and the selected mode is the manual fault clearing.
	10 Fault control is enabled for all channels, and the selected mode is the manual fault clearing.
	11 Fault control is enabled for all channels, and the selected mode is the automatic fault clearing.
4 CAPTEST	Capture Test Mode Enable
0/11/201	Enables the capture test mode.
	This field is write protected. It can be written only when MODE[WPDIS] = 1.
	0 Capture test mode is disabled.
	1 Capture test mode is enabled.
3 PWMSYNC	PWM Synchronization Mode
PWMSTNC	Selects which triggers can be used by MOD, CnV, OUTMASK, and FTM counter synchronization. See PWM synchronization. The PWMSYNC bit configures the synchronization when SYNCMODE is 0.
	0 No restrictions. Software and hardware triggers can be used by MOD, CnV, OUTMASK, and FTM counter synchronization.
	1 Software trigger can only be used by MOD and CnV synchronization, and hardware triggers can only be used by OUTMASK and FTM counter synchronization.
2 WPDIS	Write Protection Disable
	When write protection is enabled (WPDIS = 0), write protected bits cannot be written. When write protection is disabled (WPDIS = 1), write protected bits can be written. The WPDIS bit is the negation of the WPEN bit. WPDIS is cleared when 1 is written to WPEN. WPDIS is set when WPEN bit is read as a 1 and then 1 is written to WPDIS. Writing 0 to WPDIS has no effect.

Table continues on the next page...

FTMx_MODE field descriptions (continued)

Field	Description
	0 Write protection is enabled.
	1 Write protection is disabled.
1	Initialize The Channels Output
INIT	When a 1 is written to INIT bit the channels output is initialized according to the state of their corresponding bit in the OUTINIT register. Writing a 0 to INIT bit has no effect.
	The INIT bit is always read as 0.
0	FTM Enable
FTMEN	This field is write protected. It can be written only when MODE[WPDIS] = 1.
	0 TPM compatibility. Free running counter and synchronization compatible with TPM.
	1 Free running counter and synchronization are different from TPM behavior.

Synchronization (FTMx_SYNC) 39.4.11

This register configures the PWM synchronization.

A synchronization event can perform the synchronized update of MOD, CV, and OUTMASK registers with the value of their write buffer and the FTM counter initialization.

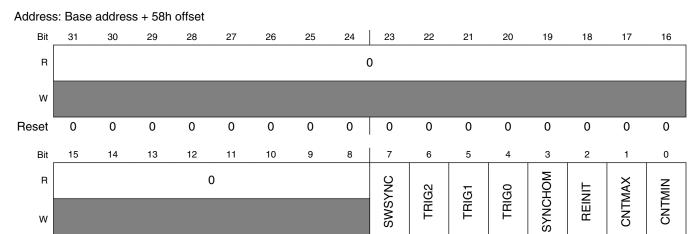
NOTE

The software trigger, SWSYNC bit, and hardware triggers TRIG0, TRIG1, and TRIG2 bits have a potential conflict if used together when SYNCMODE = 0. Use only hardware or software triggers but not both at the same time, otherwise unpredictable behavior is likely to happen.

The selection of the loading point, CNTMAX and CNTMIN bits, is intended to provide the update of MOD, CNTIN, and CnV registers across all enabled channels simultaneously. The use of the loading point selection together with SYNCMODE = 0 and hardware trigger selection, TRIG0, TRIG1, or TRIG2 bits, is likely to result in unpredictable behavior.

The synchronization event selection also depends on the PWMSYNC (MODE register) and SYNCMODE (SYNCONF register) bits. See PWM synchronization.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018 874 NXP Semiconductors



FTMx_SYNC field descriptions

Reset

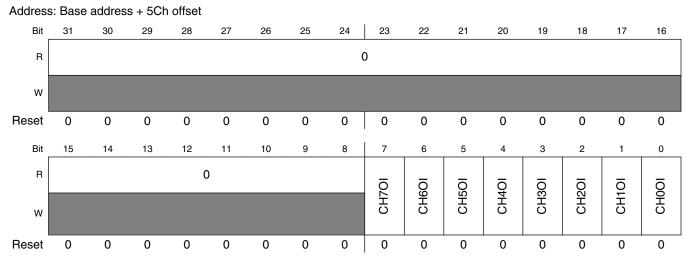
Field	Description
31–8	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
7 SWSYNC	PWM Synchronization Software Trigger
	Selects the software trigger as the PWM synchronization trigger. The software trigger happens when a 1 is written to SWSYNC bit.
	0 Software trigger is not selected.
	1 Software trigger is selected.
6 TRIG2	PWM Synchronization Hardware Trigger 2
	Enables hardware trigger 2 to the PWM synchronization. Hardware trigger 2 happens when a rising edge is detected at the trigger 2 input signal.
	0 Trigger is disabled.
	1 Trigger is enabled.
5 TRIG1	PWM Synchronization Hardware Trigger 1
	Enables hardware trigger 1 to the PWM synchronization. Hardware trigger 1 happens when a rising edge is detected at the trigger 1 input signal.
	0 Trigger is disabled.
	1 Trigger is enabled.
4 TRIG0	PWM Synchronization Hardware Trigger 0
	Enables hardware trigger 0 to the PWM synchronization. Hardware trigger 0 occurs when a rising edge is detected at the trigger 0 input signal.
	0 Trigger is disabled.
	1 Trigger is enabled.
3 SYNCHOM	Output Mask Synchronization
	Selects when the OUTMASK register is updated with the value of its buffer.

Table continues on the next page...

FTMx_SYNC field descriptions (continued)

Field	Description
	0 OUTMASK register is updated with the value of its buffer in all rising edges of the FTM input clock.
	1 OUTMASK register is updated with the value of its buffer only by the PWM synchronization.
2 REINIT	FTM Counter Reinitialization By Synchronization (FTM counter synchronization)
	Determines if the FTM counter is reinitialized when the selected trigger for the synchronization is detected. The REINIT bit configures the synchronization when SYNCMODE is zero.
	0 FTM counter continues to count normally.
	1 FTM counter is updated with its initial value when the selected trigger is detected.
1 CNTMAX	Maximum Loading Point Enable
	Selects the maximum loading point to PWM synchronization. See Synchronization Points. If CNTMAX is 1, the selected loading point is when the FTM counter reaches its maximum value (MOD register).
	0 The maximum loading point is disabled.
	1 The maximum loading point is enabled.
0 CNTMIN	Minimum Loading Point Enable
	Selects the minimum loading point to PWM synchronization. See Synchronization Points. If CNTMIN is one, the selected loading point is when the FTM counter reaches its minimum value (CNTIN register).
	0 The minimum loading point is disabled.
	1 The minimum loading point is enabled.

39.4.12 Initial State For Channels Output (FTMx_OUTINIT)



FTMx_OUTINIT field descriptions

Field	Description
31–8	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

FTMx_OUTINIT field descriptions (continued)

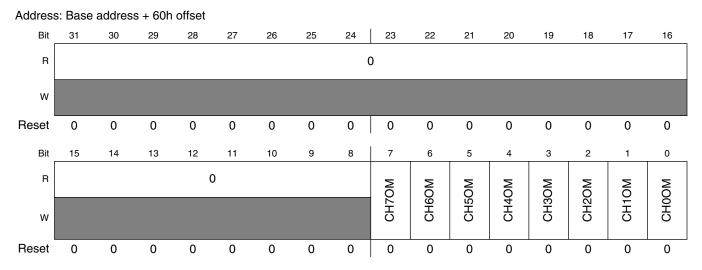
Field	Description
7	Channel 7 Output Initialization Value
CH7OI	Selects the value that is forced into the channel output when the initialization occurs.
	0 The initialization value is 0.
	1 The initialization value is 1.
6 CH6OI	Channel 6 Output Initialization Value
Crioor	Selects the value that is forced into the channel output when the initialization occurs.
	0 The initialization value is 0.
	1 The initialization value is 1.
5 CH5OI	Channel 5 Output Initialization Value
	Selects the value that is forced into the channel output when the initialization occurs.
	0 The initialization value is 0.
	1 The initialization value is 1.
4	Channel 4 Output Initialization Value
CH4OI	Selects the value that is forced into the channel output when the initialization occurs.
	0 The initialization value is 0.
	1 The initialization value is 1.
3 CH3OI	Channel 3 Output Initialization Value
CH3OI	Selects the value that is forced into the channel output when the initialization occurs.
	0 The initialization value is 0.
	1 The initialization value is 1.
2	Channel 2 Output Initialization Value
CH2OI	Selects the value that is forced into the channel output when the initialization occurs.
	0 The initialization value is 0.
	1 The initialization value is 1.
1	Channel 1 Output Initialization Value
CH1OI	Selects the value that is forced into the channel output when the initialization occurs.
	0 The initialization value is 0.
	1 The initialization value is 1.
0 CH0OI	Channel 0 Output Initialization Value
	Selects the value that is forced into the channel output when the initialization occurs.
	0 The initialization value is 0.
	1 The initialization value is 1.

39.4.13 Output Mask (FTMx_OUTMASK)

This register provides a mask for each FTM channel. The mask of a channel determines if its output responds, that is, it is masked or not, when a match occurs. This feature is used for BLDC control where the PWM signal is presented to an electric motor at specific times to provide electronic commutation.

Any write to the OUTMASK register, stores the value in its write buffer. The register is updated with the value of its write buffer according to PWM synchronization.

Output Mask bits must not be set for trigger mode.



FTMx OUTMASK field descriptions

Field	Description
31–8	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
7	Channel 7 Output Mask
СН7ОМ	Defines if the channel output is masked or unmasked.
	O Channel output is not masked. It continues to operate normally.
	1 Channel output is masked. It is forced to its inactive state.
6 CH6OM	Channel 6 Output Mask
OFFICEIN	Defines if the channel output is masked or unmasked.
	0 Channel output is not masked. It continues to operate normally.
	1 Channel output is masked. It is forced to its inactive state.
5 CH5OM	Channel 5 Output Mask
	Defines if the channel output is masked or unmasked.

Table continues on the next page...

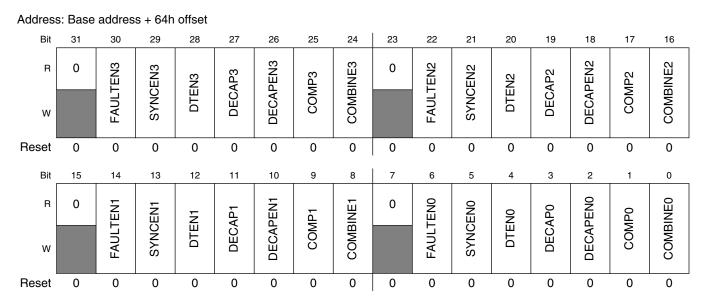
FTMx_OUTMASK field descriptions (continued)

Field	Description
	0 Channel output is not masked. It continues to operate normally.
	1 Channel output is masked. It is forced to its inactive state.
4 CH4OM	Channel 4 Output Mask
	Defines if the channel output is masked or unmasked.
	0 Channel output is not masked. It continues to operate normally.
	1 Channel output is masked. It is forced to its inactive state.
3	Channel 3 Output Mask
СНЗОМ	Defines if the channel output is masked or unmasked.
	0 Channel output is not masked. It continues to operate normally.
	1 Channel output is masked. It is forced to its inactive state.
2 CH2OM	Channel 2 Output Mask
	Defines if the channel output is masked or unmasked.
	0 Channel output is not masked. It continues to operate normally.
	1 Channel output is masked. It is forced to its inactive state.
1	Channel 1 Output Mask
CH1OM	Defines if the channel output is masked or unmasked.
	0 Channel output is not masked. It continues to operate normally.
	1 Channel output is masked. It is forced to its inactive state.
0 CH0OM	Channel 0 Output Mask
	Defines if the channel output is masked or unmasked.
	0 Channel output is not masked. It continues to operate normally.
	1 Channel output is masked. It is forced to its inactive state.

880

39.4.14 **Function For Linked Channels (FTMx_COMBINE)**

This register contains the configuration bits for each pair of channels.



FTMx_COMBINE field descriptions

Field	Description
31 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
30 FAULTEN3	Fault Control Enable For n = 6 Enables the fault control in channels (n) and (n+1). This field is write protected. It can be written only when MODE[WPDIS] = 1. 0 The fault control in this pair of channels is disabled.
	1 The fault control in this pair of channels is enabled.
29 SYNCEN3	Synchronization Enable For n = 6 Enables PWM synchronization of registers C(n)V and C(n+1)V. O The PWM synchronization in this pair of channels is disabled. The PWM synchronization in this pair of channels is enabled.
28 DTEN3	Deadtime Enable For n = 6 Enables the deadtime insertion in the channels (n) and (n+1). This field is write protected. It can be written only when MODE[WPDIS] = 1. 0 The deadtime insertion in this pair of channels is disabled. 1 The deadtime insertion in this pair of channels is enabled.
27 DECAP3	Dual Edge Capture Mode Captures For n = 6

Table continues on the next page...

FTMx_COMBINE field descriptions (continued)

Field	Description
	Enables the capture of the FTM counter value according to the channel (n) input event and the configuration of the dual edge capture bits.
	This field applies only when DECAPEN = 1.
	DECAP bit is cleared automatically by hardware if dual edge capture – one-shot mode is selected and when the capture of channel (n+1) event is made.
	The dual edge captures are inactive.The dual edge captures are active.
26 DECAPEN3	Dual Edge Capture Mode Enable For n = 6
	Enables the Dual Edge Capture mode in the channels (n) and (n+1). See Channel Modes.
0.5	This field is write protected. It can be written only when MODE[WPDIS] = 1.
25 COMP3	Complement Of Channel (n) for n = 6
	In Complementary mode the channel (n+1) output is the inverse of the channel (n) output.
	This field is write protected. It can be written only when MODE[WPDIS] = 1.
	0 The channel (n+1) output is the same as the channel (n) output.
	1 The channel (n+1) output is the complement of the channel (n) output.
24 COMBINE3	Combine Channels For n = 6
COMBINES	Used on the selection of the combine mode for channels (n) and (n+1). See Channel Modes.
	This field is write protected. It can be written only when MODE[WPDIS] = 1.
23 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
22	Fault Control Enable For n = 4
FAULTEN2	Enables the fault control in channels (n) and (n+1).
	This field is write protected. It can be written only when MODE[WPDIS] = 1.
	0 The fault control in this pair of channels is disabled.
	1 The fault control in this pair of channels is enabled.
21	Synchronization Enable For n = 4
SYNCEN2	Enables PWM synchronization of registers C(n)V and C(n+1)V.
	0 The PWM synchronization in this pair of channels is disabled.
	1 The PWM synchronization in this pair of channels is enabled.
20	Deadtime Enable For n = 4
DTEN2	Enables the deadtime insertion in the channels (n) and (n+1).
	This field is write protected. It can be written only when MODE[WPDIS] = 1.
	0 The deadtime insertion in this pair of channels is disabled.
	1 The deadtime insertion in this pair of channels is enabled.
19	Dual Edge Capture Mode Captures For n = 4
DECAP2	Enables the capture of the FTM counter value according to the channel (n) input event and the configuration of the dual edge capture bits.
	This field applies only when DECAPEN = 1.

Table continues on the next page...

FTMx_COMBINE field descriptions (continued)

Field	Description
	DECAP bit is cleared automatically by hardware if dual edge capture – one-shot mode is selected and
	when the capture of channel (n+1) event is made.
	0 The dual edge captures are inactive.
	1 The dual edge captures are active.
18	Dual Edge Capture Mode Enable For n = 4
DECAPEN2	Enables the Dual Edge Capture mode in the channels (n) and (n+1). See Channel Modes.
	This field is write protected. It can be written only when MODE[WPDIS] = 1.
17 COMP2	Complement Of Channel (n) For n = 4
COMP2	In Complementary mode the channel (n+1) output is the inverse of the channel (n) output.
	This field is write protected. It can be written only when MODE[WPDIS] = 1.
	The channel (n+1) output is the same as the channel (n) output.
	1 The channel (n+1) output is the complement of the channel (n) output.
16	Combine Channels For n = 4
COMBINE2	Used on the selection of the combine mode for channels (n) and (n+1). See Channel Modes.
	This field is write protected. It can be written only when MODE[WPDIS] = 1.
15 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
14	Fault Control Enable For n = 2
FAULTEN1	Enables the fault control in channels (n) and (n+1).
	This field is write protected. It can be written only when MODE[WPDIS] = 1.
	0 The fault control in this pair of channels is disabled.
	1 The fault control in this pair of channels is enabled.
13	Synchronization Enable For n = 2
SYNCEN1	Enables PWM synchronization of registers C(n)V and C(n+1)V.
	0 The PWM synchronization in this pair of channels is disabled.
	1 The PWM synchronization in this pair of channels is enabled.
12	Deadtime Enable For n = 2
DTEN1	Enables the deadtime insertion in the channels (n) and (n+1).
	This field is write protected. It can be written only when MODE[WPDIS] = 1.
	0 The deadtime insertion in this pair of channels is disabled.
	1 The deadtime insertion in this pair of channels is enabled.
11	Dual Edge Capture Mode Captures For n = 2
DECAP1	Enables the capture of the FTM counter value according to the channel (n) input event and the configuration of the dual edge capture bits.
	This field applies only when DECAPEN = 1.
	DECAP bit is cleared automatically by hardware if Dual Edge Capture – One-Shot mode is selected and when the capture of channel (n+1) event is made.

Table continues on the next page...

FTMx_COMBINE field descriptions (continued)

Field	Description
	O The dual edge captures are inactive.
	1 The dual edge captures are active.
10 DECAPEN1	Dual Edge Capture Mode Enable For n = 2
320/11 2111	Enables the Dual Edge Capture mode in the channels (n) and (n+1). See Channel Modes.
	This field is write protected. It can be written only when MODE[WPDIS] = 1.
9 COMP1	Complement Of Channel (n) For n = 2
COMPT	In Complementary mode the channel (n+1) output is the inverse of the channel (n) output.
	This field is write protected. It can be written only when MODE[WPDIS] = 1.
	 The channel (n+1) output is the same as the channel (n) output. The channel (n+1) output is the complement of the channel (n) output.
8	Combine Channels For n = 2
COMBINE1	
	Used on the selection of the combine mode for channels (n) and (n+1). See Channel Modes.
7	This field is write protected. It can be written only when MODE[WPDIS] = 1.
/ Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
6	Fault Control Enable For n = 0
FAULTEN0	Enables the fault control in channels (n) and (n+1).
	This field is write protected. It can be written only when MODE[WPDIS] = 1.
	0 The fault control in this pair of channels is disabled.
	1 The fault control in this pair of channels is enabled.
5	Synchronization Enable For n = 0
SYNCEN0	Enables PWM synchronization of registers C(n)V and C(n+1)V.
	0 The PWM synchronization in this pair of channels is disabled.
	1 The PWM synchronization in this pair of channels is enabled.
4 DTEN0	Deadtime Enable For n = 0
DIENO	Enables the deadtime insertion in the channels (n) and (n+1).
	This field is write protected. It can be written only when MODE[WPDIS] = 1.
	0 The deadtime insertion in this pair of channels is disabled.
	1 The deadtime insertion in this pair of channels is enabled.
3 DECAPO	Dual Edge Capture Mode Captures For n = 0
DECAP0	Enables the capture of the FTM counter value according to the channel (n) input event and the configuration of the dual edge capture bits.
	This field applies only when DECAPEN = 1.
	DECAP bit is cleared automatically by hardware if dual edge capture – one-shot mode is selected and when the capture of channel (n+1) event is made.
	0 The dual edge captures are inactive.
	1 The dual edge captures are active.

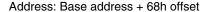
Table continues on the next page...

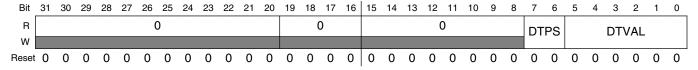
FTMx_COMBINE field descriptions (continued)

Field	Description
2	Dual Edge Capture Mode Enable For n = 0
DECAPEN0	Enables the Dual Edge Capture mode in the channels (n) and (n+1). See Channel Modes.
	This field is write protected. It can be written only when MODE[WPDIS] = 1.
1	Complement Of Channel (n) For n = 0
COMP0	In Complementary mode the channel (n+1) output is the inverse of the channel (n) output.
	This field is write protected. It can be written only when MODE[WPDIS] = 1.
	0 The channel (n+1) output is the same as the channel (n) output.
	1 The channel (n+1) output is the complement of the channel (n) output.
0	Combine Channels For n = 0
COMBINE0	Used on the selection of the combine mode for channels (n) and (n+1). See Channel Modes.
	This field is write protected. It can be written only when MODE[WPDIS] = 1.

39.4.15 Deadtime Configuration (FTMx_DEADTIME)

This register selects the deadtime prescaler and value for all pair of channels.





FTMx_DEADTIME field descriptions

Field	Description
31–20 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
19–16 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
15–8 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
7–6 DTPS	Deadtime Prescaler Value Selects the division factor of the FTM input clock. This prescaled clock is used by the deadtime counter. This field is write protected. It can be written only when MODE[WPDIS] = 1. Ox Divide the FTM input clock by 1. 10 Divide the FTM input clock by 4. 11 Divide the FTM input clock by 16.
DTVAL	Deadtime Value

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

885

FTMx_DEADTIME field descriptions (continued)

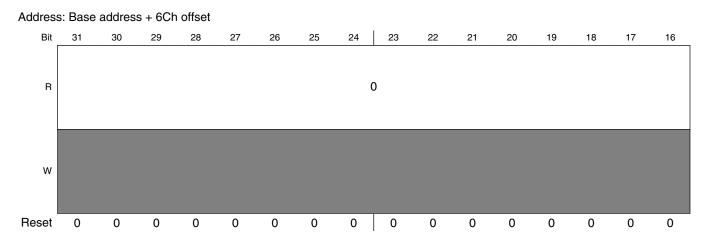
Field	Description
	Selects the deadtime value.
	Deadtime insert value = (DTPS \times DTVAL).
	This field is write protected. It can be written only when MODE[WPDIS] = 1.

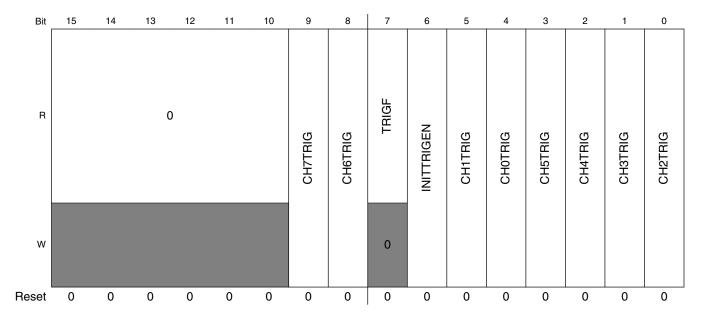
39.4.16 FTM External Trigger (FTMx_EXTTRIG)

This register:

- Indicates when a channel trigger was generated
- Enables the generation of a trigger when the FTM counter is equal to its initial value
- Selects which channels are used in the generation of the channel triggers

Several channels can be selected to generate multiple triggers in one PWM period. See External Trigger and Initialization trigger





FTMx_EXTTRIG field descriptions

Field	Description
31–10	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
9	Channel 7 Trigger Enable
CH7TRIG	Enables the generation of the channel trigger when the FTM counter is equal to the CnV register.
	0 The generation of the channel trigger is disabled.
	1 The generation of the channel trigger is enabled.
8 CH6TRIG	Channel 6 Trigger Enable
	Enables the generation of the channel trigger when the FTM counter is equal to the CnV register.
	0 The generation of the channel trigger is disabled.
	1 The generation of the channel trigger is enabled.
7	Channel Trigger Flag
TRIGF	Set by hardware when a channel trigger is generated. Clear TRIGF by reading EXTTRIG while TRIGF is set and then writing a 0 to TRIGF. Writing a 1 to TRIGF has no effect.
	If another channel trigger is generated before the clearing sequence is completed, the sequence is reset so TRIGF remains set after the clear sequence is completed for the earlier TRIGF.
	0 No channel trigger was generated.
	1 A channel trigger was generated.
6 INITTRIGEN	Initialization Trigger Enable
	Enables the generation of the trigger when the FTM counter is equal to the CNTIN register.
	0 The generation of initialization trigger is disabled.
	1 The generation of initialization trigger is enabled.
5 CH1TRIG	Channel 1 Trigger Enable

Table continues on the next page...

887

FTMx_EXTTRIG field descriptions (continued)

Field	Description
	Enables the generation of the channel trigger when the FTM counter is equal to the CnV register.
	0 The generation of the channel trigger is disabled.
	1 The generation of the channel trigger is enabled.
4 CH0TRIG	Channel 0 Trigger Enable
	Enables the generation of the channel trigger when the FTM counter is equal to the CnV register.
	0 The generation of the channel trigger is disabled.
	1 The generation of the channel trigger is enabled.
3 CH5TRIG	Channel 5 Trigger Enable
	Enables the generation of the channel trigger when the FTM counter is equal to the CnV register.
	0 The generation of the channel trigger is disabled.
	1 The generation of the channel trigger is enabled.
2 CH4TRIG	Channel 4 Trigger Enable
	Enables the generation of the channel trigger when the FTM counter is equal to the CnV register.
	0 The generation of the channel trigger is disabled.
	1 The generation of the channel trigger is enabled.
1 CH3TRIG	Channel 3 Trigger Enable
	Enables the generation of the channel trigger when the FTM counter is equal to the CnV register.
	0 The generation of the channel trigger is disabled.
	1 The generation of the channel trigger is enabled.
0 CH2TRIG	Channel 2 Trigger Enable
	Enables the generation of the channel trigger when the FTM counter is equal to the CnV register.
	0 The generation of the channel trigger is disabled.
	1 The generation of the channel trigger is enabled.

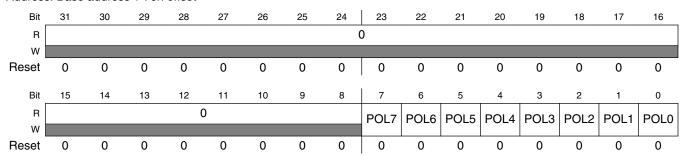
39.4.17 Channels Polarity (FTMx_POL)

This register defines the output polarity of the FTM channels.

NOTE

The safe value that is driven in a channel output when the fault control is enabled and a fault condition is detected is the inactive state of the channel. That is, the safe value of a channel is the value of its POL bit.

Address: Base address + 70h offset



FTMx_POL field descriptions

Field	Description
31–8 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
7	Channel 7 Polarity
POL7	Defines the polarity of the channel output.
	This field is write protected. It can be written only when MODE[WPDIS] = 1.
	0 The channel polarity is active high.
	1 The channel polarity is active low.
6	Channel 6 Polarity
POL6	Defines the polarity of the channel output.
	This field is write protected. It can be written only when MODE[WPDIS] = 1.
	0 The channel polarity is active high.
	1 The channel polarity is active low.
5	Channel 5 Polarity
POL5	Defines the polarity of the channel output.
	This field is write protected. It can be written only when MODE[WPDIS] = 1.
	0 The channel polarity is active high.
	1 The channel polarity is active low.
4 POL4	Channel 4 Polarity
POL4	Defines the polarity of the channel output.
	This field is write protected. It can be written only when MODE[WPDIS] = 1.
	0 The channel polarity is active high.
	1 The channel polarity is active low.
3 POL3	Channel 3 Polarity
POL3	Defines the polarity of the channel output.
	This field is write protected. It can be written only when MODE[WPDIS] = 1.
	0 The channel polarity is active high.
	1 The channel polarity is active low.
2 POL2	Channel 2 Polarity

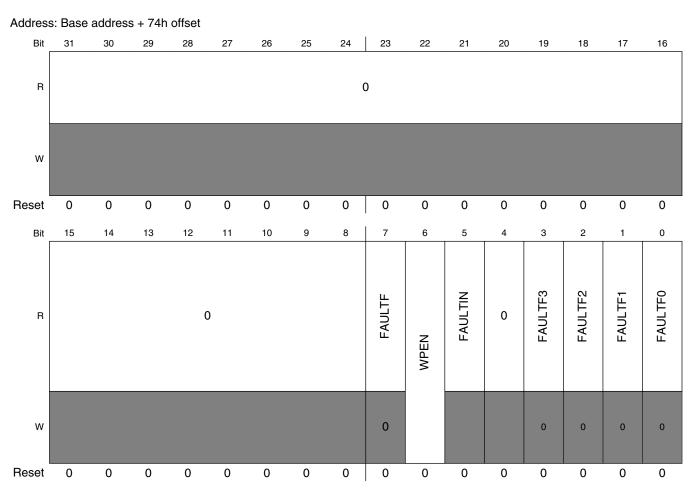
Table continues on the next page...

FTMx_POL field descriptions (continued)

Field	Description
	Defines the polarity of the channel output.
	This field is write protected. It can be written only when MODE[WPDIS] = 1.
	0 The channel polarity is active high.
	1 The channel polarity is active low.
1 POL1	Channel 1 Polarity
. 52.	Defines the polarity of the channel output.
	This field is write protected. It can be written only when MODE[WPDIS] = 1.
	0 The channel polarity is active high.
	1 The channel polarity is active low.
0 POL0	Channel 0 Polarity
	Defines the polarity of the channel output.
	This field is write protected. It can be written only when MODE[WPDIS] = 1.
	0 The channel polarity is active high.
	1 The channel polarity is active low.

39.4.18 Fault Mode Status (FTMx_FMS)

This register contains the fault detection flags, write protection enable bit, and the logic OR of the enabled fault inputs.



FTMx_FMS field descriptions

Field	Description
31–8 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
7 FAULTF	Fault Detection Flag Represents the logic OR of the individual FAULTFj bits where j = 3, 2, 1, 0. Clear FAULTF by reading the FMS register while FAULTF is set and then writing a 0 to FAULTF while there is no existing fault condition at the enabled fault inputs. Writing a 1 to FAULTF has no effect.
	If another fault condition is detected in an enabled fault input before the clearing sequence is completed, the sequence is reset so FAULTF remains set after the clearing sequence is completed for the earlier fault condition. FAULTF is also cleared when FAULTFj bits are cleared individually. On No fault condition was detected. A fault condition was detected.

Table continues on the next page...

FTMx_FMS field descriptions (continued)

Field	Description
6	Write Protection Enable
WPEN	The WPEN bit is the negation of the WPDIS bit. WPEN is set when 1 is written to it. WPEN is cleared when WPEN bit is read as a 1 and then 1 is written to WPDIS. Writing 0 to WPEN has no effect.
	0 Write protection is disabled. Write protected bits can be written.
	1 Write protection is enabled. Write protected bits cannot be written.
5 FAULTIN	Fault Inputs Penropents the logic OP of the enabled fault inputs offer their filter (if their filter is enabled) when fault
	Represents the logic OR of the enabled fault inputs after their filter (if their filter is enabled) when fault control is enabled.
	0 The logic OR of the enabled fault inputs is 0.
	1 The logic OR of the enabled fault inputs is 1.
4 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
3	Fault Detection Flag 3
FAULTF3	Set by hardware when fault control is enabled, the corresponding fault input is enabled and a fault condition is detected at the fault input.
	Clear FAULTF3 by reading the FMS register while FAULTF3 is set and then writing a 0 to FAULTF3 while there is no existing fault condition at the corresponding fault input. Writing a 1 to FAULTF3 has no effect. FAULTF3 bit is also cleared when FAULTF bit is cleared.
	If another fault condition is detected at the corresponding fault input before the clearing sequence is completed, the sequence is reset so FAULTF3 remains set after the clearing sequence is completed for the earlier fault condition.
	0 No fault condition was detected at the fault input.
	1 A fault condition was detected at the fault input.
2	Fault Detection Flag 2
FAULTF2	Set by hardware when fault control is enabled, the corresponding fault input is enabled and a fault condition is detected at the fault input.
	Clear FAULTF2 by reading the FMS register while FAULTF2 is set and then writing a 0 to FAULTF2 while there is no existing fault condition at the corresponding fault input. Writing a 1 to FAULTF2 has no effect. FAULTF2 bit is also cleared when FAULTF bit is cleared.
	If another fault condition is detected at the corresponding fault input before the clearing sequence is completed, the sequence is reset so FAULTF2 remains set after the clearing sequence is completed for the earlier fault condition.
	0 No fault condition was detected at the fault input.
	1 A fault condition was detected at the fault input.
1	Fault Detection Flag 1
FAULTF1	Set by hardware when fault control is enabled, the corresponding fault input is enabled and a fault condition is detected at the fault input.
	Clear FAULTF1 by reading the FMS register while FAULTF1 is set and then writing a 0 to FAULTF1 while there is no existing fault condition at the corresponding fault input. Writing a 1 to FAULTF1 has no effect. FAULTF1 bit is also cleared when FAULTF bit is cleared.

Table continues on the next page...

FTMx_FMS field descriptions (continued)

Field	Description
	If another fault condition is detected at the corresponding fault input before the clearing sequence is completed, the sequence is reset so FAULTF1 remains set after the clearing sequence is completed for the earlier fault condition.
	0 No fault condition was detected at the fault input.
	1 A fault condition was detected at the fault input.
0 FAULTF0	Fault Detection Flag 0
17,02110	Set by hardware when fault control is enabled, the corresponding fault input is enabled and a fault condition is detected at the fault input.
	Clear FAULTF0 by reading the FMS register while FAULTF0 is set and then writing a 0 to FAULTF0 while there is no existing fault condition at the corresponding fault input. Writing a 1 to FAULTF0 has no effect. FAULTF0 bit is also cleared when FAULTF bit is cleared.
	If another fault condition is detected at the corresponding fault input before the clearing sequence is completed, the sequence is reset so FAULTF0 remains set after the clearing sequence is completed for the earlier fault condition.
	0 No fault condition was detected at the fault input.
	1 A fault condition was detected at the fault input.

39.4.19 Input Capture Filter Control (FTMx_FILTER)

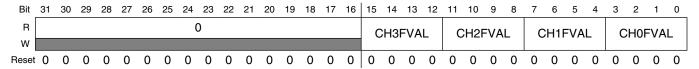
This register selects the filter value for the inputs of channels.

Channels 4, 5, 6 and 7 do not have an input filter.

NOTE

Writing to the FILTER register has immediate effect and must be done only when the channels 0, 1, 2, and 3 are not in input modes. Failure to do this could result in a missing valid signal.

Address: Base address + 78h offset



FTMx_FILTER field descriptions

Field	Description
31–16 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
15–12 CH3FVAL	Channel 3 Input Filter Selects the filter value for the channel input. The filter is disabled when the value is zero.

Table continues on the next page...

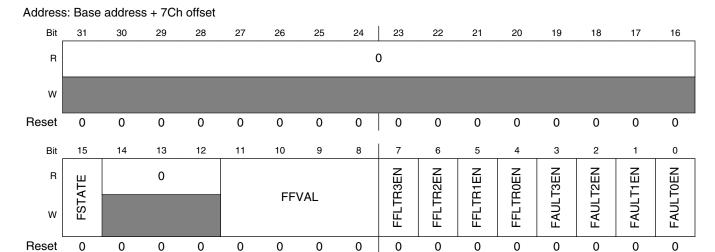
Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

FTMx_FILTER field descriptions (continued)

Field	Description
11–8	Channel 2 Input Filter
CH2FVAL	Selects the filter value for the channel input.
	The filter is disabled when the value is zero.
7–4	Channel 1 Input Filter
CH1FVAL	Selects the filter value for the channel input.
	The filter is disabled when the value is zero.
CH0FVAL	Channel 0 Input Filter
	Selects the filter value for the channel input.
	The filter is disabled when the value is zero.

39.4.20 Fault Control (FTMx_FLTCTRL)

This register selects the filter value for the fault inputs, enables the fault inputs and the fault inputs filter. This register also controls the output state when a fault event happens.



FTMx_FLTCTRL field descriptions

Field	Description
31–16 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
15 FSTATE	Fault output state This configuration allows to put the FTM outputs tri-stated when a fault event is ongoing. This field is write protected. It can be written only when MODE[WPDIS] = 1.

Table continues on the next page...

FTMx_FLTCTRL field descriptions (continued)

Field	Description
	0 FTM outputs will be placed into safe values when fault events in ongoing (defined by POL bits).
	1 FTM outputs will be tri-stated when fault event is ongoing
14–12 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
11–8 FFVAL	Fault Input Filter
FFVAL	Selects the filter value for the fault inputs.
	The fault filter is disabled when the value is zero.
	NOTE: Writing to this field has immediate effect and must be done only when the fault control or all fault inputs are disabled. Failure to do this could result in a missing fault detection.
7	Fault Input 3 Filter Enable
FFLTR3EN	Enables the filter for the fault input.
	This field is write protected. It can be written only when MODE[WPDIS] = 1.
	0 Fault input filter is disabled.
	1 Fault input filter is enabled.
6	Fault Input 2 Filter Enable
FFLTR2EN	Enables the filter for the fault input.
	This field is write protected. It can be written only when MODE[WPDIS] = 1.
	0 Fault input filter is disabled.
	1 Fault input filter is enabled.
5 FFLTR1EN	Fault Input 1 Filter Enable
FFLINIEN	Enables the filter for the fault input.
	This field is write protected. It can be written only when MODE[WPDIS] = 1.
	0 Fault input filter is disabled.
	1 Fault input filter is enabled.
4 FFLTR0EN	Fault Input 0 Filter Enable
FFLINUEN	Enables the filter for the fault input.
	This field is write protected. It can be written only when MODE[WPDIS] = 1.
	0 Fault input filter is disabled.
	1 Fault input filter is enabled.
3 FAULT3EN	Fault Input 3 Enable
FAULTSEN	Enables the fault input.
	This field is write protected. It can be written only when MODE[WPDIS] = 1.
	0 Fault input is disabled.
	1 Fault input is enabled.
2 FAULT2EN	Fault Input 2 Enable
FAUL IZEN	Enables the fault input.
	This field is write protected. It can be written only when MODE[WPDIS] = 1.

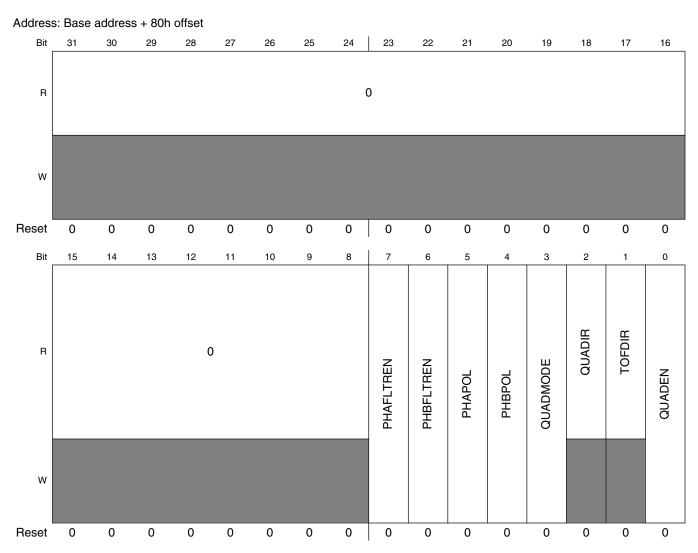
Table continues on the next page...

FTMx_FLTCTRL field descriptions (continued)

Field	Description
	0 Fault input is disabled.
	1 Fault input is enabled.
1	Fault Input 1 Enable
FAULT1EN	Enables the fault input.
	This field is write protected. It can be written only when MODE[WPDIS] = 1.
	0 Fault input is disabled.
	1 Fault input is enabled.
0	Fault Input 0 Enable
FAULT0EN	Enables the fault input.
	This field is write protected. It can be written only when MODE[WPDIS] = 1.
	0 Fault input is disabled.
	1 Fault input is enabled.

39.4.21 Quadrature Decoder Control And Status (FTMx_QDCTRL)

This register has the control and status bits for the Quadrature Decoder mode.



FTMx_QDCTRL field descriptions

Field	Description
31–8 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
7 PHAFLTREN	Phase A Input Filter Enable Enables the filter for the quadrature decoder phase A input. The filter value for the phase A input is defined by the CH0FVAL field of FILTER. The phase A filter is also disabled when CH0FVAL is zero. O Phase A input filter is disabled. 1 Phase A input filter is enabled.

Table continues on the next page...

FTMx_QDCTRL field descriptions (continued)

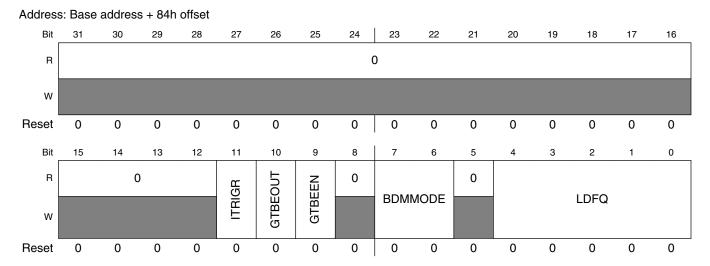
Field	Description
6	Phase B Input Filter Enable
PHBFLTREN	Enables the filter for the quadrature decoder phase B input. The filter value for the phase B input is defined by the CH1FVAL field of FILTER. The phase B filter is also disabled when CH1FVAL is zero.
	0 Phase B input filter is disabled.
	1 Phase B input filter is enabled.
5 PHAPOL	Phase A Input Polarity
FHAFOL	Selects the polarity for the quadrature decoder phase A input.
	0 Normal polarity. Phase A input signal is not inverted before identifying the rising and falling edges of this signal.
	1 Inverted polarity. Phase A input signal is inverted before identifying the rising and falling edges of this signal.
4	Phase B Input Polarity
PHBPOL	Selects the polarity for the quadrature decoder phase B input.
	Normal polarity. Phase B input signal is not inverted before identifying the rising and falling edges of this signal.
	1 Inverted polarity. Phase B input signal is inverted before identifying the rising and falling edges of this signal.
3	Quadrature Decoder Mode
QUADMODE	Selects the encoding mode used in the Quadrature Decoder mode.
	0 Phase A and phase B encoding mode.
	1 Count and direction encoding mode.
2 QUADIR	FTM Counter Direction In Quadrature Decoder Mode
	Indicates the counting direction.
	0 Counting direction is decreasing (FTM counter decrement).
	1 Counting direction is increasing (FTM counter increment).
1 TOFDIR	Timer Overflow Direction In Quadrature Decoder Mode
IOFDIR	Indicates if the TOF bit was set on the top or the bottom of counting.
	O TOF bit was set on the bottom of counting. There was an FTM counter decrement and FTM counter changes from its minimum value (CNTIN register) to its maximum value (MOD register).
	1 TOF bit was set on the top of counting. There was an FTM counter increment and FTM counter changes from its maximum value (MOD register) to its minimum value (CNTIN register).
0	Quadrature Decoder Mode Enable
QUADEN	Enables the Quadrature Decoder mode. In this mode, the phase A and B input signals control the FTM counter direction. The Quadrature Decoder mode has precedence over the other modes. See Channel Modes.
	This field is write protected. It can be written only when MODE[WPDIS] = 1.
	Quadrature Decoder mode is disabled.
	1 Quadrature Decoder mode is enabled.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

39.4.22 Configuration (FTMx_CONF)

This register selects the number of times that a reload opportunity should occur before the RF bit is set, the FTM behavior in Debug modes, the use of an external global time base, and the global time base signal generation.

This register also controls if initialization trigger should be generated when a reload point is reached.



FTMx_CONF field descriptions

Field	Description
31–12	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
11 ITRIGR	Initialization trigger on Reload Point
Titlion t	This bit controls whether an initialization trigger is generated when a reload point configured by PWMLOAD register is reached considering the FTM_CONF[LDFQ] settings.
	0 Initialization trigger is generated on counter wrap events.
	1 Initialization trigger is generated when a reload point is reached.
10	Global Time Base Output
GTBEOUT	Enables the global time base signal generation to other FTMs.
	0 A global time base signal generation is disabled.
	A global time base signal generation is enabled.
9 GTBEEN	Global Time Base Enable
GIBEEN	Configures the FTM to use an external global time base signal that is generated by another FTM.
	0 Use of an external global time base is disabled.
	Use of an external global time base is enabled.

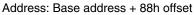
Table continues on the next page...

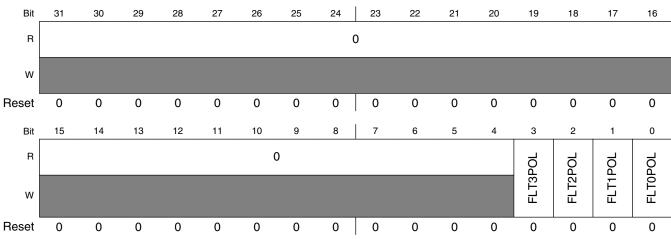
FTMx_CONF field descriptions (continued)

Field	Description
8 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
7–6 BDMMODE	Debug Mode Selects the FTM behavior in Debug mode. See Debug mode.
5 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
LDFQ	Load Frequency
	Selects PWM reload frequency.
	LDFQ = 0: RF bit is set every reload oportunity.
	LDFQ = 1: RF bit is set every 2 reload oportunities.
	LDFQ = 2: RF bit is set every 3 reload oportunities.
	LDFQ = 3: RF bit is set every 4 reload oportunities.
	This pattern continues up to a maximum of 32.

39.4.23 FTM Fault Input Polarity (FTMx_FLTPOL)

This register defines the fault inputs polarity.





FTMx_FLTPOL field descriptions

Field	Description
31–4	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
3 FLT3POL	Fault Input 3 Polarity
	Defines the polarity of the fault input.
	This field is write protected. It can be written only when MODE[WPDIS] = 1.

Table continues on the next page...

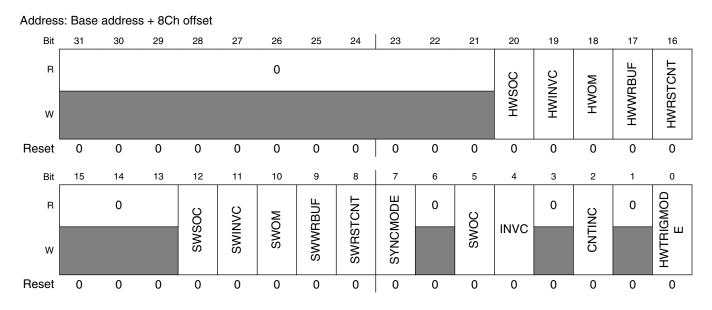
Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

FTMx_FLTPOL field descriptions (continued)

Field	Description
	The fault input polarity is active high. A 1 at the fault input indicates a fault.
	1 The fault input polarity is active low. A 0 at the fault input indicates a fault.
2 FLT2POL	Fault Input 2 Polarity
TETETOL	Defines the polarity of the fault input.
	This field is write protected. It can be written only when MODE[WPDIS] = 1.
	0 The fault input polarity is active high. A 1 at the fault input indicates a fault.
	1 The fault input polarity is active low. A 0 at the fault input indicates a fault.
1	Fault Input 1 Polarity
FLT1POL	Defines the polarity of the fault input.
	This field is write protected. It can be written only when MODE[WPDIS] = 1.
	0 The fault input polarity is active high. A 1 at the fault input indicates a fault.
	1 The fault input polarity is active low. A 0 at the fault input indicates a fault.
0 FLT0POL	Fault Input 0 Polarity
PLIUPOL	Defines the polarity of the fault input.
	This field is write protected. It can be written only when MODE[WPDIS] = 1.
	0 The fault input polarity is active high. A 1 at the fault input indicates a fault.
	1 The fault input polarity is active low. A 0 at the fault input indicates a fault.

39.4.24 Synchronization Configuration (FTMx_SYNCONF)

This register selects the PWM synchronization configuration, SWOCTRL, INVCTRL and CNTIN registers synchronization, if FTM clears the TRIGj bit, where j = 0, 1, 2, when the hardware trigger j is detected.



Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

FTMx_SYNCONF field descriptions

Field	Description
31–21 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
20 HWSOC	Software output control synchronization is activated by a hardware trigger.
	O A hardware trigger does not activate the SWOCTRL register synchronization.
10	1 A hardware trigger activates the SWOCTRL register synchronization.
19 HWINVC	Inverting control synchronization is activated by a hardware trigger.
	 A hardware trigger does not activate the INVCTRL register synchronization. A hardware trigger activates the INVCTRL register synchronization.
18 HWOM	Output mask synchronization is activated by a hardware trigger.
TIVVOIVI	0 A hardware trigger does not activate the OUTMASK register synchronization.
	1 A hardware trigger activates the OUTMASK register synchronization.
17 HWWRBUF	MOD, HCR, CNTIN, and CV registers synchronization is activated by a hardware trigger.
	 A hardware trigger does not activate MOD, HCR, CNTIN, and CV registers synchronization. A hardware trigger activates MOD, HCR, CNTIN, and CV registers synchronization.
16	FTM counter synchronization is activated by a hardware trigger.
HWRSTCNT	A hardware trigger does not activate the FTM counter synchronization.
	A hardware trigger activates the FTM counter synchronization.
15–13 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
12 SWSOC	Software output control synchronization is activated by the software trigger.
	O The software trigger does not activate the SWOCTRL register synchronization.
	1 The software trigger activates the SWOCTRL register synchronization.
11 SWINVC	Inverting control synchronization is activated by the software trigger.
	O The software trigger does not activate the INVCTRL register synchronization.
10	1 The software trigger activates the INVCTRL register synchronization.
10 SWOM	Output mask synchronization is activated by the software trigger.
	 The software trigger does not activate the OUTMASK register synchronization. The software trigger activates the OUTMASK register synchronization.
9	MOD, HCR, CNTIN, and CV registers synchronization is activated by the software trigger.
SWWRBUF	
	 The software trigger does not activate MOD, HCR, CNTIN, and CV registers synchronization. The software trigger activates MOD, HCR, CNTIN, and CV registers synchronization.
8	FTM counter synchronization is activated by the software trigger.
SWRSTCNT	The software trigger does not activate the FTM counter synchronization.
	1 The software trigger activates the FTM counter synchronization.
7	Synchronization Mode
SYNCMODE	Selects the PWM Synchronization mode.

Table continues on the next page...

Memory map and register definition

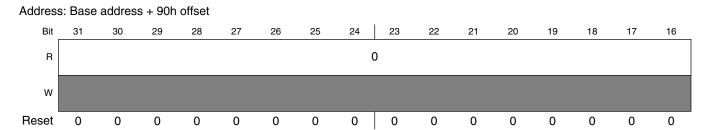
FTMx_SYNCONF field descriptions (continued)

Field	Description
	Legacy PWM synchronization is selected.
	1 Enhanced PWM synchronization is selected.
6	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
5 SWOC	SWOCTRL Register Synchronization
	SWOCTRL register is updated with its buffer value at all rising edges of FTM input clock.
	1 SWOCTRL register is updated with its buffer value by the PWM synchronization.
4 INVC	INVCTRL Register Synchronization
	0 INVCTRL register is updated with its buffer value at all rising edges of FTM input clock.
	INVCTRL register is updated with its buffer value by the PWM synchronization.
3	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
2 CNTINC	CNTIN Register Synchronization
	0 CNTIN register is updated with its buffer value at all rising edges of FTM input clock.
	1 CNTIN register is updated with its buffer value by the PWM synchronization.
1	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
0 HWTRIGMODE	Hardware Trigger Mode
	0 FTM clears the TRIGj bit when the hardware trigger j is detected, where $j = 0, 1,2$.
	1 FTM does not clear the TRIGj bit when the hardware trigger j is detected, where $j = 0, 1,2$.

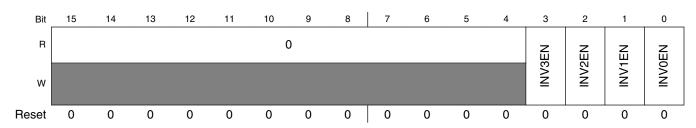
FTM Inverting Control (FTMx_INVCTRL) 39.4.25

This register controls when the channel (n) output becomes the channel (n+1) output, and channel (n+1) output becomes the channel (n) output. Each INVmEN bit enables the inverting operation for the corresponding pair channels m.

This register has a write buffer. The INVmEN bit is updated by the INVCTRL register synchronization.



Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018 902 **NXP Semiconductors**



FTMx_INVCTRL field descriptions

Field	Description
31–4 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
3 INV3EN	Pair Channels 3 Inverting Enable
	0 Inverting is disabled.
	1 Inverting is enabled.
2 INV2EN	Pair Channels 2 Inverting Enable
	0 Inverting is disabled.
	1 Inverting is enabled.
1 INV1EN	Pair Channels 1 Inverting Enable
	0 Inverting is disabled.
	1 Inverting is enabled.
0	Pair Channels 0 Inverting Enable
INV0EN	
	0 Inverting is disabled.
	1 Inverting is enabled.

39.4.26 FTM Software Output Control (FTMx_SWOCTRL)

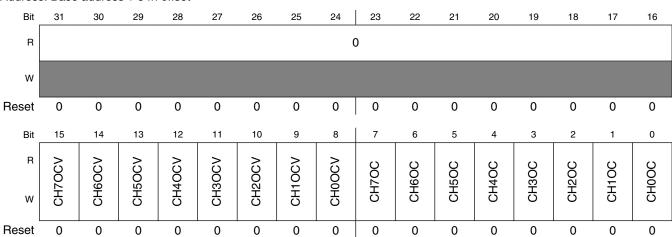
This register enables software control of channel (n) output and defines the value forced to the channel (n) output:

- The CH(n)OC bits enable the control of the corresponding channel (n) output by software.
- The CH(n)OCV bits select the value that is forced at the corresponding channel (n) output.

This register has a write buffer. The fields are updated by the SWOCTRL register synchronization.

Memory map and register definition

Address: Base address + 94h offset



FTMx_SWOCTRL field descriptions

Field	Description	
31–16	This field is reserved.	
Reserved	This read-only field is reserved and always has the value 0.	
15 CH7OCV	Channel 7 Software Output Control Value	
	0 The software output control forces 0 to the channel output.	
	1 The software output control forces 1 to the channel output.	
14 CH6OCV	Channel 6 Software Output Control Value	
	0 The software output control forces 0 to the channel output.	
	1 The software output control forces 1 to the channel output.	
13 CH5OCV	Channel 5 Software Output Control Value	
	0 The software output control forces 0 to the channel output.	
	1 The software output control forces 1 to the channel output.	
12 CH4OCV	Channel 4 Software Output Control Value	
	0 The software output control forces 0 to the channel output.	
	1 The software output control forces 1 to the channel output.	
11 CH3OCV	Channel 3 Software Output Control Value	
	0 The software output control forces 0 to the channel output.	
	1 The software output control forces 1 to the channel output.	
10 CH2OCV	Channel 2 Software Output Control Value	
	0 The software output control forces 0 to the channel output.	
	1 The software output control forces 1 to the channel output.	
9 CH1OCV	Channel 1 Software Output Control Value	
	0 The software output control forces 0 to the channel output.	
	1 The software output control forces 1 to the channel output.	
8 CH0OCV	Channel 0 Software Output Control Value	

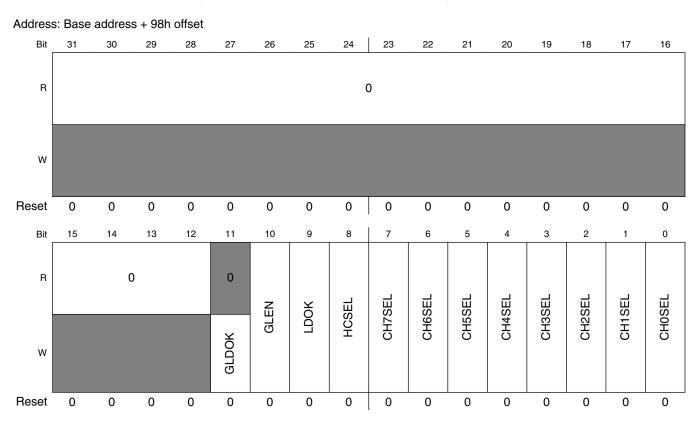
Table continues on the next page...

FTMx_SWOCTRL field descriptions (continued)

Field	Description	
	0 The software output control forces 0 to the channel output.	
	1 The software output control forces 1 to the channel output.	
7 CH7OC	Channel 7 Software Output Control Enable	
011700	0 The channel output is not affected by software output control.	
	1 The channel output is affected by software output control.	
6 CH6OC	Channel 6 Software Output Control Enable	
	0 The channel output is not affected by software output control.	
	1 The channel output is affected by software output control.	
5 CH5OC	Channel 5 Software Output Control Enable	
	0 The channel output is not affected by software output control.	
	1 The channel output is affected by software output control.	
4 CH4OC	Channel 4 Software Output Control Enable	
	0 The channel output is not affected by software output control.	
	1 The channel output is affected by software output control.	
3 CH3OC	Channel 3 Software Output Control Enable	
	0 The channel output is not affected by software output control.	
	1 The channel output is affected by software output control.	
2 CH2OC	Channel 2 Software Output Control Enable	
	0 The channel output is not affected by software output control.	
	1 The channel output is affected by software output control.	
1 CH1OC	Channel 1 Software Output Control Enable	
	0 The channel output is not affected by software output control.	
	1 The channel output is affected by software output control.	
0 CH0OC	Channel 0 Software Output Control Enable	
	0 The channel output is not affected by software output control.	
	1 The channel output is affected by software output control.	

39.4.27 FTM PWM Load (FTMx_PWMLOAD)

Enables the reload of the MOD, HCR, CNTIN, C(n)V, and C(n+1)V registers with the values of their write buffers when the FTM counter changes from the MOD register value to its next value or when a channel (j) match occurs. A match occurs for channel (j) when FTM counter = C(j)V. A reload can also occurs when FTM counter = HCR register at a half cycle match. This register also controls the local and global load mechanisms.



FTMx_PWMLOAD field descriptions

Field	Description
31–12 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
11 GLDOK	Global Load OK This bit controls the global load mechanism. It generates a pulse at FTM module global load output with one FTM clock cycle width, which is used to set LDOK bits of FTM and other modules (including other FTMs). This bit is self-cleared and read value is always zero.
	The global load mechanism depends on SoC specific information. Refer to FTM SoC specific information to more details. O No action. LDOK bit is set.

Table continues on the next page...

FTMx_PWMLOAD field descriptions (continued)

Field	Description
10	Global Load Enable
GLEN	This bit enables the global load mechanism implemented by GLDOK. If GLEN bit is set, then an external event on the FTM global load input sets the LDOK bit. The clear of the LDOK bit is done by CPU writes '0' to the bit.
	0 Global Load Ok disabled.
	1 Global Load OK enabled. A pulse event on the module global load input sets the LDOK bit.
9	Load Enable
LDOK	Enables the loading of the MOD, CNTIN, HCR and CV registers with the values of their buffers.
	The LDOK bit can also be set by the Global Load mechanism if GLEN bit is enabled.
	0 Loading updated values is disabled.1 Loading updated values is enabled.
8	Half Cycle Select
HCSEL	This bit enables the half cycle match as a reload oportunity. A half cycle is defined by when the FTM counter matches the HCR register.
	0 Half cycle reload is disabled and it is not considered as a reload opportunity.
	1 Half cycle reload is enabled and it is considered as a reload opportunity.
7 CH7SEL	Channel 7 Select
0022	0 Channel match is not included as a reload opportunity.
	1 Channel match is included as a reload opportunity.
6 CH6SEL	Channel 6 Select
	O Channel match is not included as a reload opportunity.
_	1 Channel match is included as a reload opportunity.
5 CH5SEL	Channel 5 Select
	0 Channel match is not included as a reload opportunity.
	1 Channel match is included as a reload opportunity.
4 CH4SEL	Channel 4 Select
0622	0 Channel match is not included as a reload opportunity.
	1 Channel match is included as a reload opportunity.
3 CH3SEL	Channel 3 Select
ONIOOLL	0 Channel match is not included as a reload opportunity.
	1 Channel match is included as a reload opportunity.
2 CH2SEL	Channel 2 Select
	O Channel match is included as a reload opportunity.
1	Channel match is included as a reload opportunity. Channel 1 Select
CH1SEL	
	O Channel match is not included as a reload opportunity.
	1 Channel match is included as a reload opportunity.

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Memory map and register definition

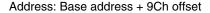
FTMx_PWMLOAD field descriptions (continued)

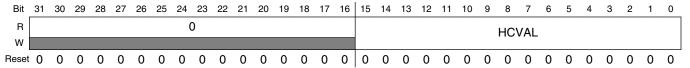
Field	Description	
0	Channel 0 Select	
CH0SEL	O Channel match is not included as a valend amount with	
	O Channel match is not included as a reload opportunity.	
	1 Channel match is included as a reload opportunity.	

39.4.28 Half Cycle Register (FTMx_HCR)

The Half Cycle Register contains the match value for FTM half cycle reload feature. After FTM counter reaches this value, a reload opportunity is generated if FTM_PWMLOAD[HCSEL] is enabled.

Writing to the HCR register latches the value into a buffer. The HCR register is updated with the value of its write buffer according to Registers updated from write buffers.





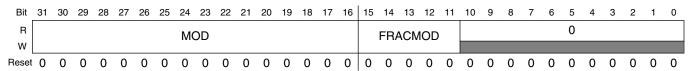
FTMx_HCR field descriptions

Field	Description	
31–16 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.	
HCVAL	Half Cycle Value	

39.4.29 Mirror of Modulo Value (FTMx_MOD_MIRROR)

This register contains the integer and fractional modulo value for the FTM counter.

Address: Base address + 200h offset



NXP Semiconductors

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

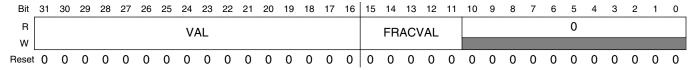
FTMx_MOD_MIRROR field descriptions

Field	Description	
31–16 MOD	Mirror of the Modulo Integer Value	
	See the field MOD of the register MOD.	
15–11	Modulo Fractional Value	
FRACMOD	The modulo fractional value is used in the PWM period dithering. This value is added to an internal accumulator at the end of each PWM period.	
	Writes to the field FRACMOD are done on its write buffer. The FRACMOD is updated with its write buffer value according to Registers updated from write buffers. If FTMEN = 0, a write to SC register resets manually this write coherency mechanism.	
Reserved	This field is reserved. This read-only field is reserved and always has the value 0.	

39.4.30 Mirror of Channel (n) Match Value (FTMx_CnV_MIRROR)

This register contains the integer and fractional value of the channel (n) match.

Address: Base address + 204h offset + (4d × i), where i=0d to 7d



FTMx_CnV_MIRROR field descriptions

Field	Description
31–16	Mirror of the Channel (n) Match Integer Value
VAL	See the field VAL of the register CnV.
15–11	Channel (n) Match Fractional Value
FRACVAL	The channel (n) match fractional value is used in the PWM edge dithering. This value is added to the channel (n) internal accumulator at the end of each PWM period.
	Writes to the field FRACVAL are done on its write buffer. The FRACVAL is updated with its write buffer value according to Registers updated from write buffers. If FTMEN = 0, a write to CnSC register resets manually this write coherency mechanism.
Reserved	This field is reserved. This read-only field is reserved and always has the value 0.

39.5 Functional description

The notation used in this document to represent the counters and the generation of the signals is shown in the following figure.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

FTM counting is up.
Channel (n) is in high-true EPWM mode.
PS[2:0] = 001

CNTIN = 0x0000 MOD = 0x0004 CnV = 0x0002

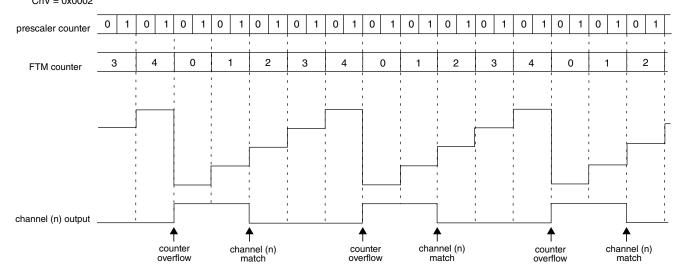


Figure 39-4. Notation used

39.5.1 Clock source

The FTM has only one clock domain: the FTM input clock.

39.5.1.1 Counter clock source

The CLKS[1:0] bits in the SC register select one of three possible clock sources for the FTM counter or disable the FTM counter. After any chip reset, CLKS[1:0] = 0:0 so no clock source is selected.

The CLKS[1:0] bits may be read or written at any time. Disabling the FTM counter by writing 0:0 to the CLKS[1:0] bits does not affect the FTM counter value or other registers.

The fixed frequency clock is an alternative clock source for the FTM counter that allows the selection of a clock other than the FTM input clock or an external clock. This clock input is defined by chip integration. Refer to the chip specific documentation for further information. Due to FTM hardware implementation limitations, the frequency of the fixed frequency clock must not exceed 1/2 of the FTM input clock frequency.

The external clock passes through a synchronizer clocked by the FTM input clock to assure that counter transitions are properly aligned to FTM input clock transitions. Therefore, to meet Nyquist criteria considering also jitter, the frequency of the external clock source must not exceed 1/4 of the FTM input clock frequency.

39.5.2 Prescaler

The selected counter clock source passes through a prescaler that is a 7-bit counter. The value of the prescaler is selected by the PS[2:0] bits. The following figure shows an example of the prescaler counter and FTM counter.

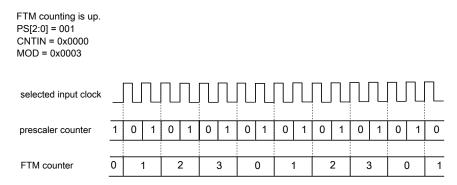


Figure 39-5. Example of the prescaler counter

39.5.3 Counter

The FTM has a 16-bit counter that is used by the channels either for input or output modes. The FTM counter clock is the selected clock divided by the prescaler.

The FTM counter has these modes of operation:

- Up counting
- Up-down counting
- Quadrature Decoder mode

39.5.3.1 Up counting

Up counting is selected when:

- QUADEN = 0, and
- CPWMS = 0

CNTIN defines the starting value of the count and MOD defines the final value of the count, see the following figure. The value of CNTIN is loaded into the FTM counter, and the counter increments until the value of MOD is reached, at which point the counter is reloaded with the value of CNTIN.

The FTM period when using up counting is $(MOD - CNTIN + 0x0001) \times period of the FTM counter clock.$

The TOF bit is set when the FTM counter changes from MOD to CNTIN.

A counter event happens at the same time of TOF bit set when the FTM counter changes from MOD to CNTIN. See Counter events for more details.

FTM counting is up.

CNTIN = 0xFFFC (in two's complement is equal to -4)

MOD = 0x0004

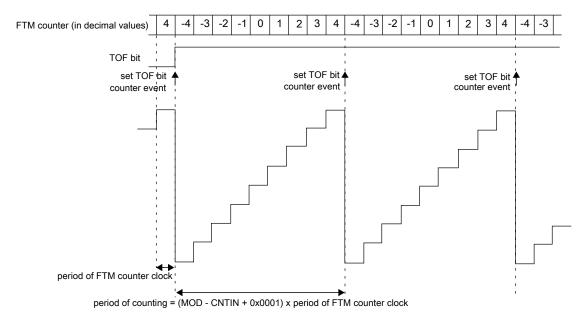


Figure 39-6. Example of FTM up and signed counting

Table 39-3. FTM counting based on CNTIN value

When	Then
CNTIN = 0x0000	The FTM counting is equivalent to TPM up counting, that is, up and unsigned counting. See the following figure.
CNTIN[15] = 1	The initial value of the FTM counter is a negative number in two's complement, so the FTM counting is up and signed.
CNTIN[15] = 0 and CNTIN ≠ 0x0000	The initial value of the FTM counter is a positive number, so the FTM counting is up and unsigned.

FTM counting is up CNTIN = 0x0000 MOD = 0x0004

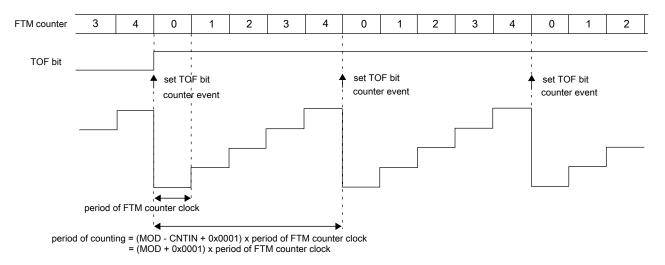


Figure 39-7. Example of FTM up counting with CNTIN = 0x0000

Note

- FTM operation is only valid when the value of the CNTIN register is less than the value of the MOD register, either in the unsigned counting or signed counting. It is the responsibility of the software to ensure that the values in the CNTIN and MOD registers meet this requirement. Any values of CNTIN and MOD that do not satisfy this criteria can result in unpredictable behavior.
- MOD = CNTIN is a redundant condition. In this case, the FTM counter is always equal to MOD and the TOF bit is set in each rising edge of the FTM counter clock.
- When MOD = 0x0000, CNTIN = 0x0000, for example after reset, and FTMEN = 1, the FTM counter remains stopped at 0x0000 until a non-zero value is written into the MOD or CNTIN registers.
- Setting CNTIN to be greater than the value of MOD is not recommended as this unusual setting may make the FTM operation difficult to comprehend. However, there is no restriction on this configuration, and an example is shown in the following figure.

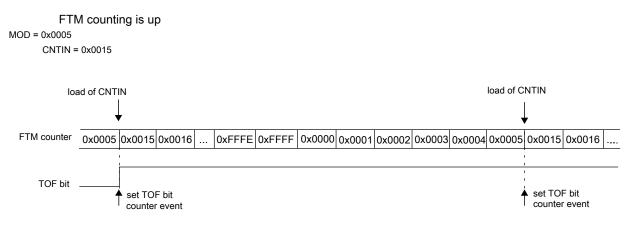


Figure 39-8. Example of up counting when the value of CNTIN is greater than the value of MOD

39.5.3.2 Up-down counting

Up-down counting is selected when:

- QUADEN = 0, and
- CPWMS = 1

CNTIN defines the starting value of the count and MOD defines the final value of the count. The value of CNTIN is loaded into the FTM counter, and the counter increments until the value of MOD is reached, at which point the counter is decremented until it returns to the value of CNTIN and the up-down counting restarts.

The FTM period when using up-down counting is $2 \times (MOD - CNTIN) \times period of the FTM counter clock.$

The TOF bit is set when the FTM counter changes from MOD to (MOD - 1).

If (CNTIN = 0x0000), the FTM counting is equivalent to TPM up-down counting, that is, up-down and unsigned counting. See the following figure.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

FTM counting is up-down CNTIN = 0x0000 MOD = 0x0004

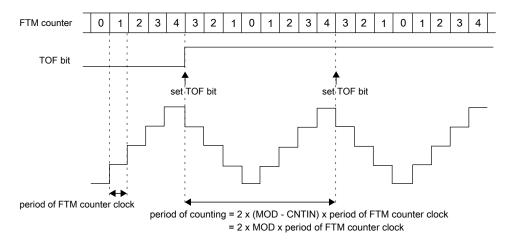


Figure 39-9. Example of up-down counting when CNTIN = 0x0000

Note

When CNTIN is different from zero in the up-down counting, a valid CPWM signal is generated:

- if CnV > CNTIN, or
- if CnV = 0 or if CnV[15] = 1. In this case, 0% CPWM is generated.

The figure below shows the possible counter events when in up-down counting mode. See Counter events for more details.

FTM counting is up-down CNTIN = 0x0000 MOD = 0x0004

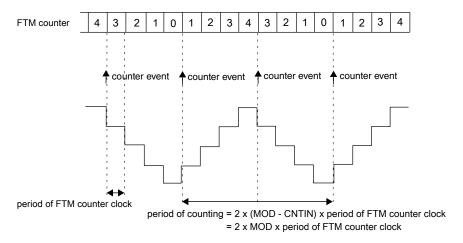


Figure 39-10. Example of counter events in up-down counting mode when CNTIN = 0x0000

39.5.3.3 Free running counter

If (FTMEN = 0) and (MOD = 0x0000 or MOD = 0xFFFF), the FTM counter is a free running counter. In this case, the FTM counter runs free from 0x0000 through 0xFFFF and the TOF bit is set when the FTM counter changes from 0xFFFF to 0x0000. See the following figure.

A counter event occurs at the same time of TOF bit set when the FTM counter changes from 0xFFFF to 0x0000. See Counter events for more details.

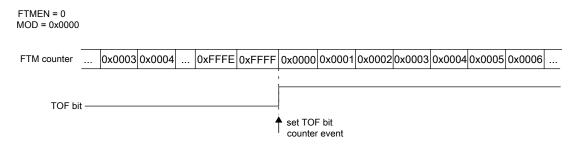


Figure 39-11. Example when the FTM counter is free running

The FTM counter is also a free running counter when:

- FTMEN = 1
- QUADEN = 0
- CPWMS = 0
- CNTIN = 0x0000, and
- MOD = 0xFFFF

39.5.3.4 Counter reset

Any one of the following cases resets the FTM counter to the value in the CNTIN register and the channels output to its initial value, except for channels in Output Compare mode.

- Any write to CNT.
- FTM counter synchronization.
- A channel in Input Capture mode with ICRST = 1 (FTM Counter Reset in Input Capture Mode).

Note that reseting the counter also generates a counter event. See Counter events for more details.

39.5.3.5 Counter events

Counter events can be used as reload opportunities to FTM register sychronization mechanism. See Reload Points for more details. There are some possible counter events depending on the counter mode. Please see the table below for more details.

Table 39-4. FTM counter events

When	Then
FTM counter is in up counting mode or freerunning	 A counter event happens at the same time of TOF bit set when the FTM counter changes from MOD to CNTIN (counter wrap). Figure at Up counting shows the counter event generation. When in freerunning, there is a counter event when FTM counter changes from 0xFFFF to 0x0000. Figure at Free running counter shows the counter event generation.
FTM counter is in up-down counting mode	In up-down counting mode, there are two possible counter events when FTM counter turns from down to up counting and when counter turns from up to down counting. User can select which point will be used to generate the counter event. Figure at Up-down counting shows the possible counter events.
FTM counter is reseted (see Counter reset) or a value different from zero is written at CLKS field	 In up-counting mode, all counter reset events or a write in the CLKS with a value different from zero generates a counter event. In up-down counting mode, counter reset events only generates a counter event if the minimum load point when FTM counter turns from down to up counting is configured. A write in the CLKS with a value different from zero always generates a counter event in up-down counting mode.

39.5.4 Channel Modes

The following table shows the channel modes selection.

Table 39-5. Channel Modes Selection

DECAPEN	COMBINE	CPWMS	MSB:MSA	ELSB:ELSA	Mode	Configuration
X	Х	X	XX	00	channel pin to ge	FTM—revert the neral purpose I/O oheral control
0	0	0	00	01	Input Capture	Capture on Rising Edge Only
				10		Capture on Falling Edge Only

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Table 39-5. Channel Modes Selection (continued)

DECAPEN	COMBINE	CPWMS	MSB:MSA	ELSB:ELSA	Mode	Configuration
				11		Capture on Rising or Falling Edge
			01	01	Output Compare	Toggle Output on match
				10		Clear Output on match
				11		Set Output on match
			1X	10	Edge-Aligned PWM	High-true pulses (clear Output on match)
				X1		Low-true pulses (set Output on match)
		1	XX	10	Center-Aligned PWM	High-true pulses (clear Output on match-up)
				X1		Low-true pulses (set Output on match-up)
	1	0	XX	10	Combine PWM	High-true pulses (set on channel (n) match, and clear on channel (n+1) match)
				X1		Low-true pulses (clear on channel (n) match, and set on channel (n +1) match)
1	0	0	X0	See Table 39-6.	Dual Edge Capture	One-Shot Capture mode
			X1			Continuous Capture mode

Table 39-6. Dual Edge Capture Mode — Edge Polarity Selection

ELSB	ELSA	Channel Port Enable	Detected Edges
0	0	Disabled	No edge
0	1	Enabled	Rising edge
1	0	Enabled	Falling edge
1	1	Enabled	Rising and falling edges

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

39.5.5 Input Capture mode

The Input Capture mode is selected when:

- DECAPEN = 0
- **COMBINE** = 0
- CPWMS = 0
- MSB:MSA = 0:0, and
- ELSB:ELSA ≠ 0:0

When a selected edge occurs on the channel input, the current value of the FTM counter is captured into the CnV register, at the same time the CHF bit is set and the channel interrupt is generated if enabled by CHIE = 1. See the following figure.

When a channel is configured for input capture, the FTMxCHn pin is an edge-sensitive input. ELSB:ELSA control bits determine which edge, falling or rising, triggers input-capture event. Note that the maximum frequency for the channel input signal to be detected correctly is FTM input clock divided by 4, which is required to meet Nyquist criteria for signal sampling.

Writes to the CnV register is ignored in Input Capture mode.

While in Debug mode, the input capture function works as configured. When a selected edge event occurs, the FTM counter value, which is frozen because of Debug, is captured into the CnV register and the CHF bit is set.

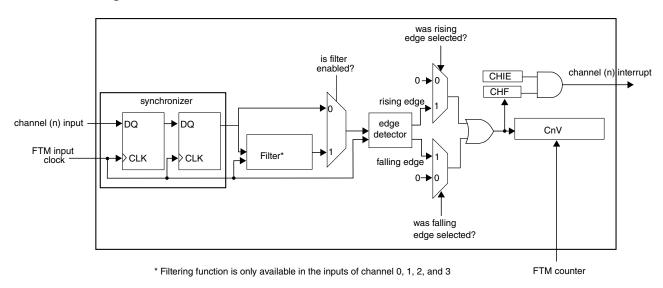


Figure 39-12. Input Capture mode

If the channel input does not have a filter enabled, then the input signal is always delayed 3 rising edges of the FTM input clock, that is, two rising edges to the synchronizer plus one more rising edge to the edge detector. In other words, the CHF bit is set on the third rising edge of the FTM input clock after a valid edge occurs on the channel input.

39.5.5.1 Filter for Input Capture mode

The filter function is only available on channels 0, 1, 2, and 3.

First, the input signal is synchronized by the FTM input clock. Following synchronization, the input signal enters the filter block. See the following figure.

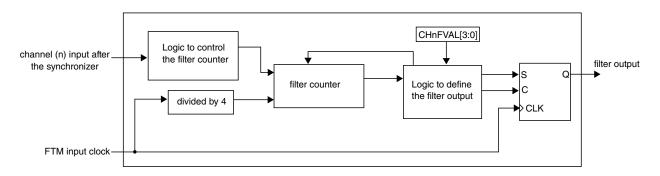


Figure 39-13. Channel input filter

NOTE

The Channel Input Filter internal counter clock is further divided by 4 in order to reject high frequency glitches.

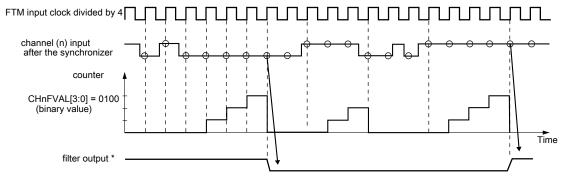
When there is a state change in the input signal, the counter is reset and starts counting up. As long as the new state is stable on the input, the counter continues to increment. When the counter is equal to CHnFVAL[3:0], the state change of the input signal is validated. It is then transmitted as a pulse edge to the edge detector.

If the opposite edge appears on the input signal before it can be validated, the counter is reset. At the next input transition, the counter starts counting again. Any pulse that is shorter than the minimum value selected by $(CHnFVAL[3:0] \times 4$ system clock cycles) is regarded as a glitch and is not passed on to the edge detector. A timing diagram of the input filter is shown in the following figure.

The filter function is disabled when CHnFVAL[3:0] bits are zero. In this case, the input signal is delayed 3 clock edges of the FTM input clock. If (CHnFVAL[3:0] \neq 0000), then the input signal is delayed by the minimum pulse width (CHnFVAL[3:0] \times 4 FTM input clocks) plus a further 4 rising edges of the FTM input clock: two rising edges to the

synchronizer, one rising edge to the filter output, plus one more to the edge detector. In other words, CHF is set $(4 + 4 \times \text{CHnFVAL}[3:0])$ FTM input clock periods after a valid edge occurs on the channel input.

The clock for the counter in the channel input filter is the system clock divided by 4.



^{*} Note: Filter output is delayed one system clock of filter counter logic output.

Figure 39-14. Channel input filter example

The figure below shows the delay through the input filter logic considering each internal filter element. Note that the input signal is delayed only by the synchronizer and edge dector logic if the filter is disabled.

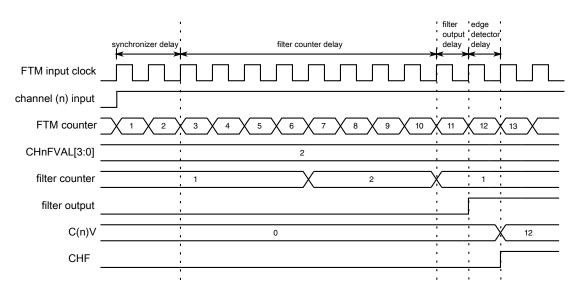


Figure 39-15. Input capture example

39.5.5.2 FTM Counter Reset in Input Capture Mode

NXP Semiconductors

If the channel (n) is in input capture mode and CnSC[ICRST = 1], then when the selected input capture event occurs in the channel (n) input signal, the current value of the FTM counter is captured into the CnV register, the CHF bit is set, the channel (n) interrupt is generated (if CHIE = 1) and the FTM counter is reset to the CNTIN register value.

This allows the FTM to measure a period/pulse being applied to the channel (n) input (number of the FTM input clocks) without having to implement a subtraction calculation in software subsequent to the event occurring.

The figure below shows the FTM counter reset when the selected input capture event is detected in a channel in input capture mode with ICRST = 1.

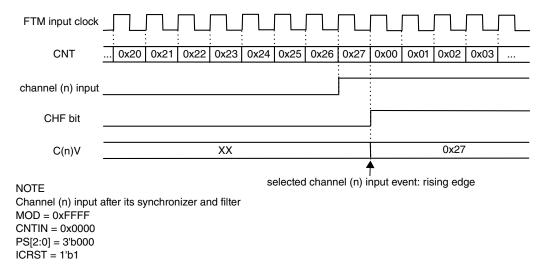


Figure 39-16. Example of the Input Capture mode with ICRST = 1

NOTE

- It is expected that the ICRST bit be set only when the channel is in input capture mode.
- If the FTM counter is reset because the channel is in input capture mode with ICRST = 1, then the prescaler counter (Prescaler) is also reset.

39.5.6 Output Compare mode

The Output Compare mode is selected when:

- DECAPEN = 0
- COMBINE = 0
- CPWMS = 0, and
- MSB:MSA = 0:1

In Output Compare mode, the FTM can generate timed pulses with programmable position, polarity, duration, and frequency. When the counter matches the value in the CnV register of an output compare channel, the channel (n) output can be set, cleared, or toggled.

When a channel is initially configured to Toggle mode, the previous value of the channel output is held until the first output compare event occurs.

The CHF bit is set and the channel (n) interrupt is generated if CHIE = 1 at the channel (n) match (FTM counter = CnV).

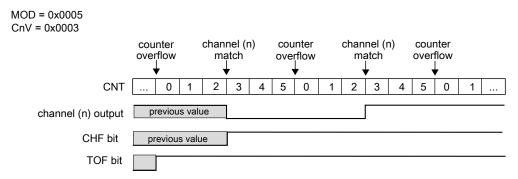


Figure 39-17. Example of the Output Compare mode when the match toggles the channel output

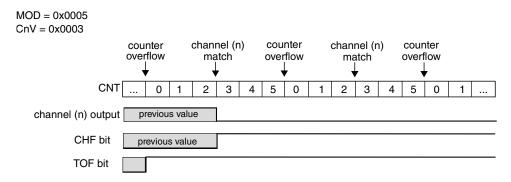


Figure 39-18. Example of the Output Compare mode when the match clears the channel output

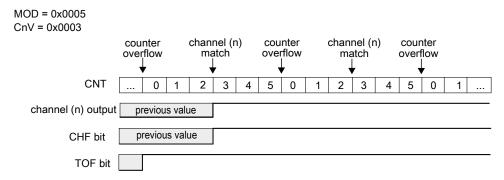


Figure 39-19. Example of the Output Compare mode when the match sets the channel output

If (ELSB:ELSA = 0:0) when the counter reaches the value in the CnV register, the CHF bit is set and the channel (n) interrupt is generated if CHIE = 1, however the channel (n) output is not modified and controlled by FTM.

39.5.7 Edge-Aligned PWM (EPWM) mode

The Edge-Aligned mode is selected when:

- QUADEN = 0
- DECAPEN = 0
- COMBINE = 0
- CPWMS = 0, and
- MSB = 1

The EPWM period is determined by (MOD - CNTIN + 0x0001) and the pulse width $(duty \ cycle)$ is determined by (CnV - CNTIN).

The CHF bit is set and the channel (n) interrupt is generated if CHIE = 1 at the channel (n) match (FTM counter = CnV), that is, at the end of the pulse width.

This type of PWM signal is called edge-aligned because the leading edges of all PWM signals are aligned with the beginning of the period, which is the same for all channels within an FTM.

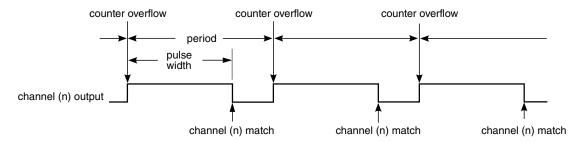


Figure 39-20. EPWM period and pulse width with ELSB:ELSA = 1:0

If (ELSB:ELSA = 0:0) when the counter reaches the value in the CnV register, the CHF bit is set and the channel (n) interrupt is generated if CHIE = 1, however the channel (n) output is not controlled by FTM.

If (ELSB:ELSA = 1:0), then the channel (n) output is forced high at the counter overflow when the CNTIN register value is loaded into the FTM counter, and it is forced low at the channel (n) match (FTM counter = CnV). See the following figure.

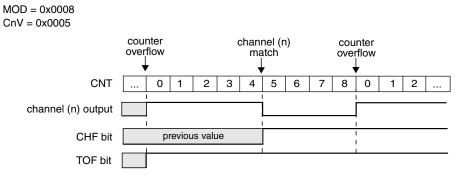


Figure 39-21. EPWM signal with ELSB:ELSA = 1:0

If (ELSB:ELSA = X:1), then the channel (n) output is forced low at the counter overflow when the CNTIN register value is loaded into the FTM counter, and it is forced high at the channel (n) match (FTM counter = CnV). See the following figure.

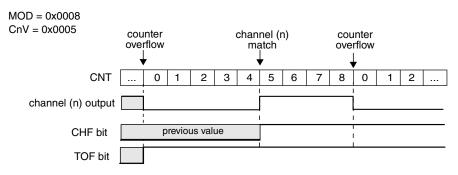


Figure 39-22. EPWM signal with ELSB:ELSA = X:1

If (CnV = 0x0000), then the channel (n) output is a 0% duty cycle EPWM signal and CHF bit is not set even when there is the channel (n) match.

If (CnV > MOD), then the channel (n) output is a 100% duty cycle EPWM signal and CHF bit is not set. Therefore, MOD must be less than 0xFFFF in order to get a 100% duty cycle EPWM signal.

Note

When CNTIN is different from zero the following EPWM signals can be generated:

- 0% EPWM signal if CnV = CNTIN,
- EPWM signal between 0% and 100% if CNTIN < CnV <= MOD,
- 100% EPWM signal when CNTIN > CnV or CnV > MOD.

39.5.8 Center-Aligned PWM (CPWM) mode

The Center-Aligned mode is selected when:

- QUADEN = 0
- DECAPEN = 0
- COMBINE = 0, and
- CPWMS = 1

The CPWM pulse width (duty cycle) is determined by $2 \times (CnV - CNTIN)$ and the period is determined by $2 \times (MOD - CNTIN)$. See the following figure. MOD must be kept in the range of 0x0001 to 0x7FFF because values outside this range can produce ambiguous results.

In the CPWM mode, the FTM counter counts up until it reaches MOD and then counts down until it reaches CNTIN.

The CHF bit is set and channel (n) interrupt is generated (if CHIE = 1) at the channel (n) match (FTM counter = CnV) when the FTM counting is down (at the begin of the pulse width) and when the FTM counting is up (at the end of the pulse width).

This type of PWM signal is called center-aligned because the pulse width centers for all channels are aligned with the value of CNTIN.

The other channel modes are not compatible with the up-down counter (CPWMS = 1). Therefore, all FTM channels must be used in CPWM mode when (CPWMS = 1).

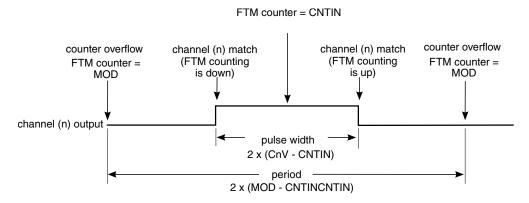


Figure 39-23. CPWM period and pulse width with ELSB:ELSA = 1:0

If (ELSB:ELSA = 0:0) when the FTM counter reaches the value in the CnV register, the CHF bit is set and the channel (n) interrupt is generated (if CHIE = 1), however the channel (n) output is not controlled by FTM.

If (ELSB:ELSA = 1:0), then the channel (n) output is forced high at the channel (n) match (FTM counter = CnV) when counting down, and it is forced low at the channel (n) match when counting up. See the following figure.



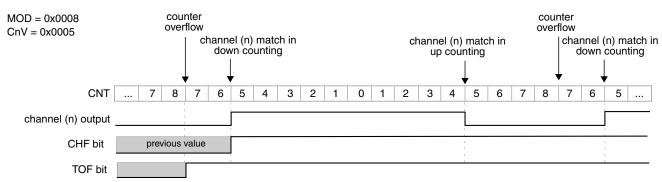


Figure 39-24. CPWM signal with ELSB:ELSA = 1:0

If (ELSB:ELSA = X:1), then the channel (n) output is forced low at the channel (n) match (FTM counter = CnV) when counting down, and it is forced high at the channel (n) match when counting up. See the following figure.

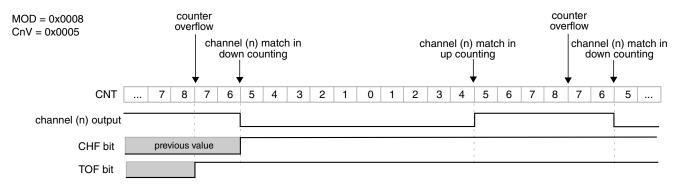


Figure 39-25. CPWM signal with ELSB:ELSA = X:1

If (CnV = 0x0000) or CnV is a negative value, that is (CnV[15] = 1), then the channel (n) output is a 0% duty cycle CPWM signal and CHF bit is not set even when there is the channel (n) match.

If CnV is a positive value, that is (CnV[15] = 0), $(CnV \ge MOD)$, and $(MOD \ne 0x0000)$, then the channel (n) output is a 100% duty cycle CPWM signal and CHF bit is not set even when there is the channel (n) match. This implies that the usable range of periods set by MOD is 0x0001 through 0x7FFE, 0x7FFF if you do not need to generate a 100% duty cycle CPWM signal. This is not a significant limitation because the resulting period is much longer than required for normal applications.

The CPWM mode must not be used when the FTM counter is a free running counter.

39.5.9 Combine mode

The Combine mode is selected when:

• QUADEN = 0

- DECAPEN = 0
- COMBINE = 1, and
- CPWMS = 0

In Combine mode, an even channel (n) and adjacent odd channel (n+1) are combined to generate a PWM signal in the channel (n) output.

In the Combine mode, the PWM period is determined by (MOD – CNTIN + 0x0001) and the PWM pulse width (duty cycle) is determined by (|C(n+1)V - C(n)V|).

The CHF bit is set and the channel (n) interrupt is generated (if CHIE = 1) at the channel (n) match (FTM counter = C(n)V). The channel (n+1) CHF bit is set and the channel (n +1) interrupt is generated, if channel (n+1) CHIE = 1, at the channel (n+1) match (FTM counter = C(n+1)V).

If (ELSB:ELSA = 1:0), then the channel (n) output is forced low at the beginning of the period (FTM counter = CNTIN) and at the channel (n+1) match (FTM counter = C(n+1)) +1)V). It is forced high at the channel (n) match (FTM counter = C(n)V). See the following figure.

If (ELSB:ELSA = X:1), then the channel (n) output is forced high at the beginning of the period (FTM counter = CNTIN) and at the channel (n+1) match (FTM counter = C(n+1)) +1)V). It is forced low at the channel (n) match (FTM counter = C(n)V). See the following figure.

In Combine mode, the channel (n) ELSB and channel (n) ELSA bits are not used in the generation of the channels (n) and (n+1) output. However, if (ELSB:ELSA = 0:0) then the channel (n) output is not controlled by FTM, and if (channel (n+1) ELSB:ELSA = 0:0) then the channel (n+1) output is not controlled by FTM.

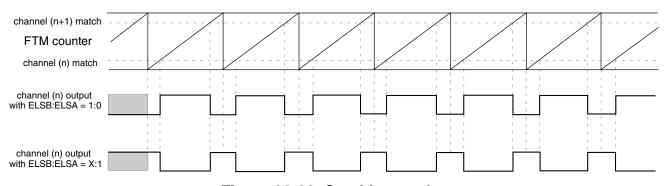


Figure 39-26. Combine mode

The following figures illustrate the PWM signals generation using Combine mode.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018 928 NXP Semiconductors

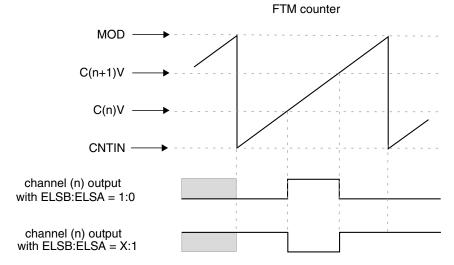


Figure 39-27. Channel (n) output if (CNTIN < C(n)V < MOD) and (CNTIN < C(n+1)V < MOD) and (C(n)V < C(n+1)V)

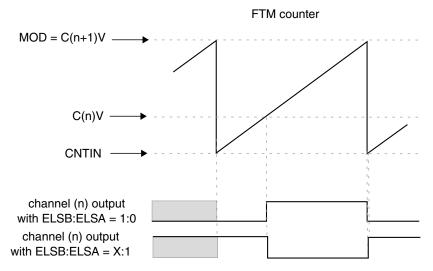


Figure 39-28. Channel (n) output if (CNTIN < C(n)V < MOD) and (C(n+1)V = MOD)

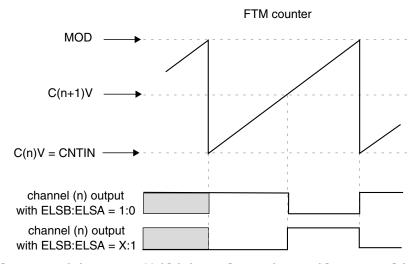


Figure 39-29. Channel (n) output if (C(n)V = CNTIN) and (CNTIN < C(n+1)V < MOD)

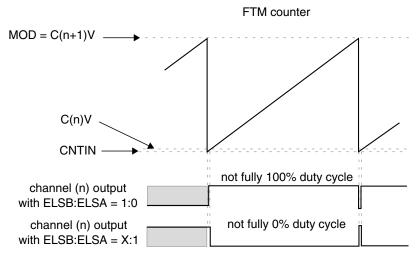


Figure 39-30. Channel (n) output if (CNTIN < C(n)V < MOD) and (C(n)V is Almost Equal to CNTIN) and (C(n+1)V = MOD)

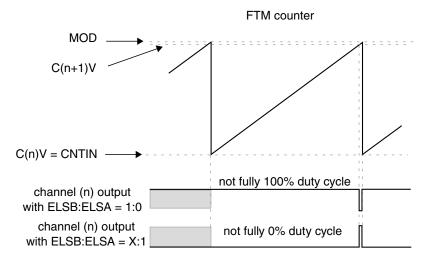


Figure 39-31. Channel (n) output if (C(n)V = CNTIN) and (CNTIN < C(n+1)V < MOD) and (C(n+1)V is Almost Equal to MOD)

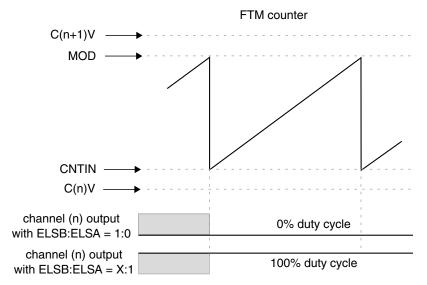


Figure 39-32. Channel (n) output if C(n)V and C(n+1)V are not between CNTIN and MOD

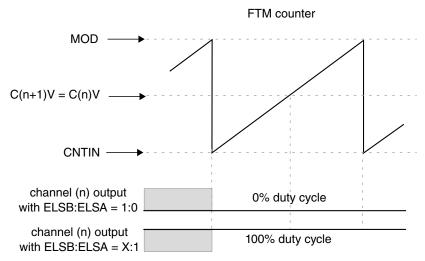


Figure 39-33. Channel (n) output if (CNTIN < C(n)V < MOD) and (CNTIN < C(n+1)V < MOD) and (C(n)V = C(n+1)V)

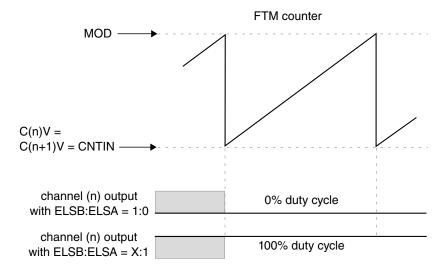


Figure 39-34. Channel (n) output if (C(n)V = C(n+1)V = CNTIN)

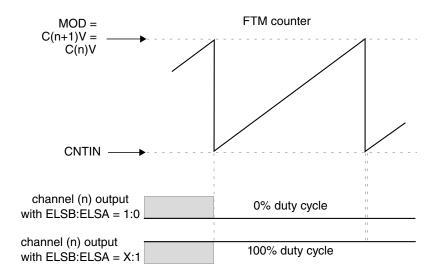


Figure 39-35. Channel (n) output if (C(n)V = C(n+1)V = MOD)

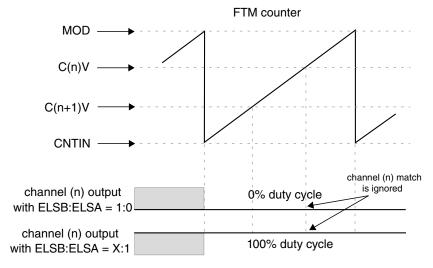


Figure 39-36. Channel (n) output if (CNTIN < C(n)V < MOD) and (CNTIN < C(n+1)V < MOD) and (C(n)V > C(n+1)V)

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

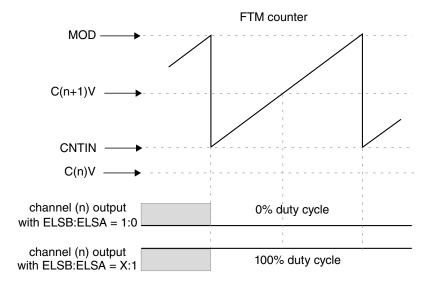


Figure 39-37. Channel (n) output if (C(n)V < CNTIN) and (CNTIN < C(n+1)V < MOD)

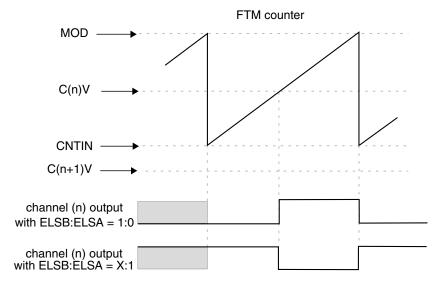


Figure 39-38. Channel (n) output if (C(n+1)V < CNTIN) and (CNTIN < C(n)V < MOD)

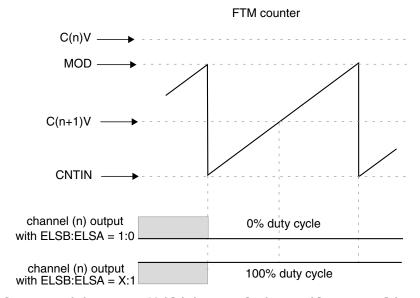


Figure 39-39. Channel (n) output if (C(n)V > MOD) and (CNTIN < C(n+1)V < MOD)

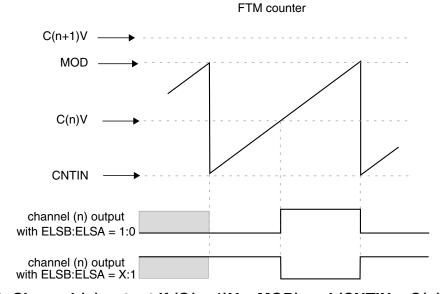


Figure 39-40. Channel (n) output if (C(n+1)V > MOD) and (CNTIN < C(n)V < MOD)

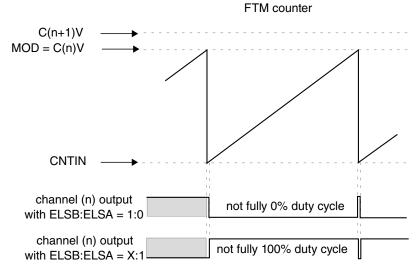


Figure 39-41. Channel (n) output if (C(n+1)V > MOD) and (CNTIN < C(n)V = MOD)

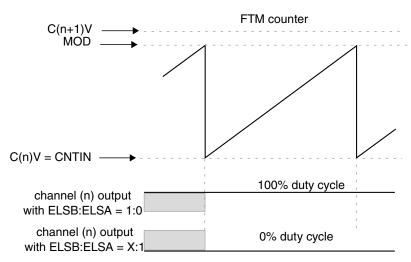


Figure 39-42. Channel (n) output if (C(n)V = CNTIN) and (C(n+1)V > MOD)

Asymmetrical PWM 39.5.9.1

In Combine mode, the PWM first edge (channel (n) match: FTM counter = C(n)V) is independent of the PWM second edge (channel (n+1) match: FTM counter = C(n+1)V).

39.5.10 **Complementary Mode**

The Complementary mode is selected when:

- QUADEN = 0
- DECAPEN = 0
- COMP = 1

In Complementary mode, the channel (n+1) output is the inverse of the channel (n) output.

So, the channel (n+1) output is the same as the channel (n) output when:

- QUADEN = 0
- DECAPEN = 0
- COMP = 0

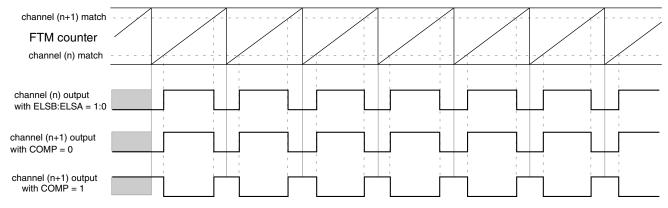


Figure 39-43. Channel (n+1) output in Complementary mode with (ELSB:ELSA = 1:0)

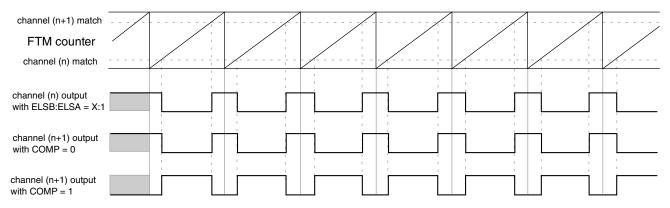


Figure 39-44. Channel (n+1) output in Complementary mode with (ELSB:ELSA = X:1)

NOTE

The Complementary Mode is not available on Output Compare mode.

39.5.11 Registers updated from write buffers

FTM has many ways to synchronize PWM registers. Current implementation allows to bypass the buffers, use legacy and PWM synchronization (hardware and software trigger) and it is also possible to use a half or full cycle reload strategy.

39.5.11.1 CNTIN register update

The following table describes when CNTIN register is updated:

Table 39-7. CNTIN register update

When	Then CNTIN register is updated		
CLKS[1:0] = 0:0	When CNTIN register is written, independent of FTMEN bit.		
• FTMEN = 0, or • CNTINC = 0	At the next FTM input clock after CNTIN was written.		
FTMEN = 1,SYNCMODE = 1, andCNTINC = 1	By the CNTIN register synchronization.		
• CNTINC = 1, and • LDOK = 1	By the Reload Points.		

39.5.11.2 MOD and HCR registers update

The following table describes when MOD or HCR registers are updated:

Table 39-8. MOD and HCR updates

When	Then MOD or HCR is updated			
CLKS[1:0] = 0:0	When MOD (or HCR) is written, independent of FTMEN bit.			
 CLKS[1:0] ≠ 0:0, and FTMEN = 0 	According to the CPWMS bit, that is: If the selected mode is not CPWM then MOD (or HCR) is updated after MOD (or HCR) register was written and the FTM counter changes from MOD to CNTIN. If the FTM counter is at free-running counter mode then this update occurs when the FTM counter changes from 0xFFFF to 0x0000. If the selected mode is CPWM then MOD (or HCR) register is updated after MOD (or HCR) register was written and the FTM counter changes from MOD to (MOD – 0x0001).			
 CLKS[1:0] ≠ 0:0, and FTMEN = 1 	By the MOD register synchronization. HCR follows the same procedure of MOD register in this case.			
• LDOK = 1	By the Reload Points.			

39.5.11.3 CnV register update

The following table describes when CnV register is updated:

Table 39-9. CnV register update

When	Then CnV register is updated	
CLKS[1:0] = 0:0	When CnV register is written, independent of FTMEN bit.	

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Table 39-9. CnV register update (continued)

When	Then CnV register is updated		
 CLKS[1:0] ≠ 0:0, and FTMEN = 0 	According to the selected mode, that is:		
T PIVILIN = U	 If the selected mode is Output Compare, then CnV register is updated on the next FTM counter change, end of the prescaler counting, after CnV register was written. If the selected mode is EPWM, then CnV register is updated after CnV register was written and the FTM counter changes from MOD to CNTIN. If the FTM counter is at free-running counter mode then this update occurs when the FTM counter changes from 0xFFFF to 0x0000. If the selected mode is CPWM, then CnV register is updated after CnV register was written and the FTM counter changes from MOD to (MOD – 0x0001). 		
 CLKS[1:0] ≠ 0:0, and FTMEN = 1 	According to the selected mode, that is: If the selected mode is output compare then CnV register is updated according to the SYNCEN bit. If (SYNCEN = 0) then CnV register is updated after CnV register was written at the next change of the FTM counter, the end of the prescaler counting. If (SYNCEN = 1) then CnV register is updated by the C(n)V and C(n+1)V register synchronization. If the selected mode is not output compare and (SYNCEN = 1) then CnV register is updated by the C(n)V and C(n+1)V register synchronization.		
 SYNCEN = 1, and LDOK = 1 	By the Reload Points.		

39.5.12 PWM synchronization

The PWM synchronization provides an opportunity to update the MOD, HCR, CNTIN, CnV, OUTMASK, INVCTRL and SWOCTRL registers with their buffered value and force the FTM counter to the CNTIN register value.

Note

The legacy PWM synchronization (SYNCMODE = 0) is a subset of the enhanced PWM synchronization (SYNCMODE = 1). Thus, only the enhanced PWM synchronization must be used.

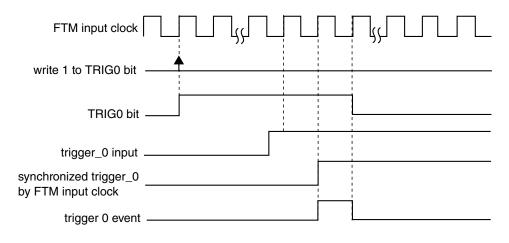
39.5.12.1 Hardware trigger

Three hardware trigger signal inputs of the FTM module are enabled when TRIGn = 1, where n = 0, 1 or 2 corresponding to each one of the input signals, respectively. The hardware trigger input n is synchronized by the FTM input clock. The PWM synchronization with hardware trigger is initiated when a rising edge is detected at the enabled hardware trigger inputs.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

If (HWTRIGMODE = 0) then the TRIGn bit is cleared when 0 is written to it or when the trigger n event is detected.

In this case, if two or more hardware triggers are enabled (for example, TRIG0 and TRIG1 = 1) and only trigger 1 event occurs, then only TRIG1 bit is cleared. If a trigger n event occurs together with a write setting TRIGn bit, then the synchronization is initiated, but TRIGn bit remains set due to the write operation.



Note All hardware trigger inputs have the same behavior.

Figure 39-45. Hardware trigger event with HWTRIGMODE = 0

If HWTRIGMODE = 1, then the TRIGn bit is only cleared when 0 is written to it.

NOTE

The HWTRIGMODE bit must be 1 only with enhanced PWM synchronization (SYNCMODE = 1).

39.5.12.2 Software trigger

A software trigger event occurs when 1 is written to the SYNC[SWSYNC] bit. The SWSYNC bit is cleared when 0 is written to it or when the PWM synchronization, initiated by the software event, is completed.

If another software trigger event occurs (by writing another 1 to the SWSYNC bit) at the same time the PWM synchronization initiated by the previous software trigger event is ending, a new PWM synchronization is started and the SWSYNC bit remains equal to 1.

If SYNCMODE = 0 then the SWSYNC bit is also cleared by FTM according to PWMSYNC and REINIT bits. In this case if (PWMSYNC = 1) or (PWMSYNC = 0 and REINIT = 0) then SWSYNC bit is cleared at the next selected loading point after that the

software trigger event occurred; see Synchronization Points and the following figure. If (PWMSYNC = 0) and (REINIT = 1) then SWSYNC bit is cleared when the software trigger event occurs.

If SYNCMODE = 1 then the SWSYNC bit is also cleared by FTM according to the SWRSTCNT bit. If SWRSTCNT = 0 then SWSYNC bit is cleared at the next selected loading point after that the software trigger event occurred; see the following figure. If SWRSTCNT = 1 then SWSYNC bit is cleared when the software trigger event occurs.

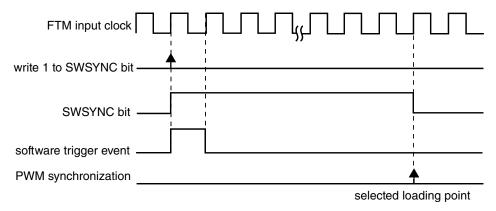


Figure 39-46. Software trigger event

39.5.12.3 Synchronization Points

The synchronization points are points where the registers can be updated with their write buffer by PWM synchronization. These synchronization points are safe points because guarantee smooth transitions in the generated PWM signals.

In Up counting mode, the synchronization points are when the FTM counter changes from MOD to CNTIN. In this case, the synchronization points are enabled if (CNTMIN = 1) or (CNTMAX = 1).

In Up-down counting mode, the synchronization points are:

- if (CNTMAX = 1), when the FTM counter changes from (MOD 1) to MOD;
- if (CNTMIN = 1), when the FTM counter changes from (CNTIN + 1) to CNTIN.

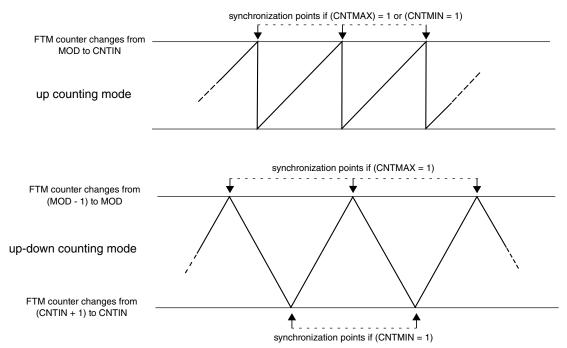


Figure 39-47. Synchronization Points

39.5.12.4 MOD register synchronization

The MOD register synchronization updates the MOD register with its buffer value. This synchronization is enabled if (FTMEN = 1).

The MOD register synchronization can be done by either the enhanced PWM synchronization (SYNCMODE = 1) or the legacy PWM synchronization (SYNCMODE = 0). However, it is expected that the MOD register be synchronized only by the enhanced PWM synchronization.

In the case of enhanced PWM synchronization, the MOD register synchronization depends on SWWRBUF, SWRSTCNT, HWWRBUF, and HWRSTCNT bits according to this flowchart:

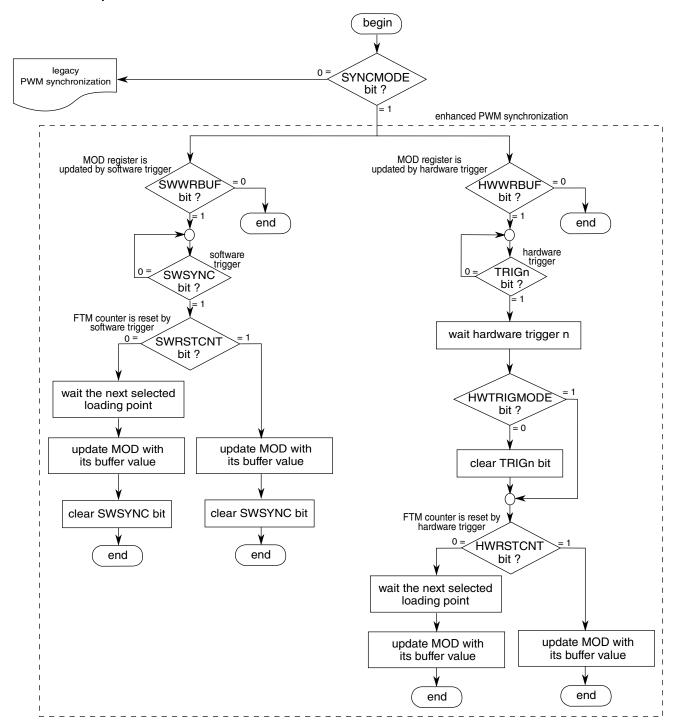


Figure 39-48. MOD register synchronization flowchart

In the case of legacy PWM synchronization, the MOD register synchronization depends on PWMSYNC and REINIT bits according to the following description.

If (SYNCMODE = 0), (PWMSYNC = 0), and (REINIT = 0), then this synchronization is made on the next selected loading point after an enabled trigger event takes place. If the trigger event was a software trigger, then the SWSYNC bit is cleared on the next selected

loading point. If the trigger event was a hardware trigger, then the trigger enable bit (TRIGn) is cleared according to Hardware trigger. Examples with software and hardware triggers follow.

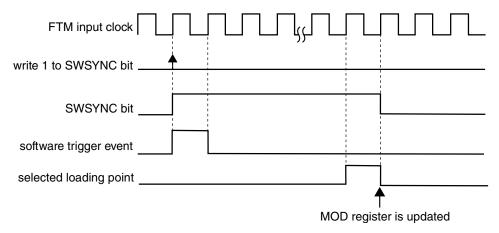


Figure 39-49. MOD synchronization with (SYNCMODE = 0), (PWMSYNC = 0), (REINIT = 0), and software trigger was used

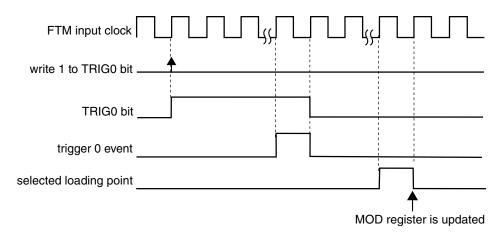


Figure 39-50. MOD synchronization with (SYNCMODE = 0), (HWTRIGMODE = 0), (PWMSYNC = 0), (REINIT = 0), and a hardware trigger was used

If (SYNCMODE = 0), (PWMSYNC = 0), and (REINIT = 1), then this synchronization is made on the next enabled trigger event. If the trigger event was a software trigger, then the SWSYNC bit is cleared according to the following example. If the trigger event was a hardware trigger, then the TRIGn bit is cleared according to Hardware trigger. Examples with software and hardware triggers follow.

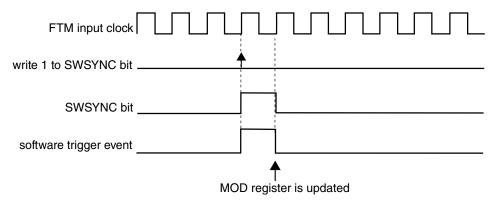


Figure 39-51. MOD synchronization with (SYNCMODE = 0), (PWMSYNC = 0), (REINIT = 1), and software trigger was used

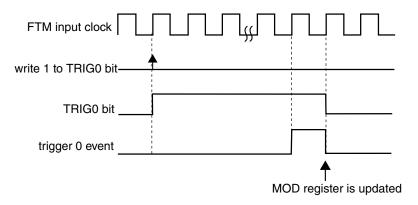


Figure 39-52. MOD synchronization with (SYNCMODE = 0), (HWTRIGMODE = 0), (PWMSYNC = 0), (REINIT = 1), and a hardware trigger was used

If (SYNCMODE = 0) and (PWMSYNC = 1), then this synchronization is made on the next selected loading point after the software trigger event takes place. The SWSYNC bit is cleared on the next selected loading point:

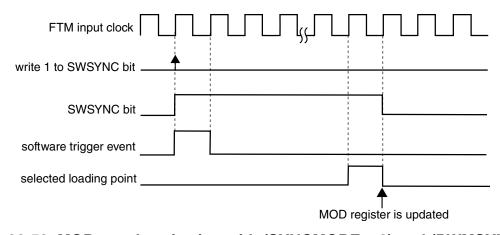


Figure 39-53. MOD synchronization with (SYNCMODE = 0) and (PWMSYNC = 1)

39.5.12.5 CNTIN register synchronization

The CNTIN register synchronization updates the CNTIN register with its buffer value.

This synchronization is enabled if (FTMEN = 1), (SYNCMODE = 1), and (CNTINC = 1). The CNTIN register synchronization can be done only by the enhanced PWM synchronization (SYNCMODE = 1). The synchronization mechanism is the same as the MOD register synchronization done by the enhanced PWM synchronization; see MOD register synchronization.

39.5.12.6 C(n)V and C(n+1)V register synchronization

The C(n)V and C(n+1)V registers synchronization updates the C(n)V and C(n+1)V registers with their buffer values.

This synchronization is enabled if (FTMEN = 1) and (SYNCEN = 1). The synchronization mechanism is the same as the MOD register synchronization. However, it is expected that the C(n)V and C(n+1)V registers be synchronized only by the enhanced PWM synchronization (SYNCMODE = 1).

39.5.12.7 OUTMASK register synchronization

The OUTMASK register synchronization updates the OUTMASK register with its buffer value.

The OUTMASK register can be updated at each rising edge of FTM input clock (SYNCHOM = 0), by the enhanced PWM synchronization (SYNCHOM = 1 and SYNCMODE = 1) or by the legacy PWM synchronization (SYNCHOM = 1 and SYNCMODE = 0). However, it is expected that the OUTMASK register be synchronized only by the enhanced PWM synchronization.

In the case of enhanced PWM synchronization, the OUTMASK register synchronization depends on SWOM and HWOM bits. See the following flowchart:

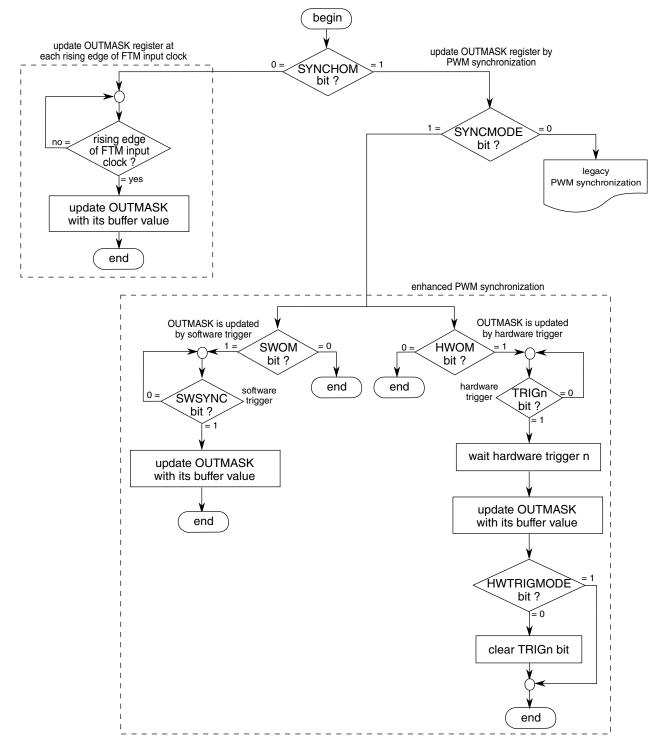


Figure 39-54. OUTMASK register synchronization flowchart

In the case of legacy PWM synchronization, the OUTMASK register synchronization depends on PWMSYNC bit according to the following description.

If (SYNCMODE = 0), (SYNCHOM = 1), and (PWMSYNC = 0), then this synchronization is done on the next enabled trigger event. If the trigger event was a software trigger, then the SWSYNC bit is cleared on the next selected loading point. If the trigger event was a hardware trigger, then the TRIGn bit is cleared according to Hardware trigger. Examples with software and hardware triggers follow.

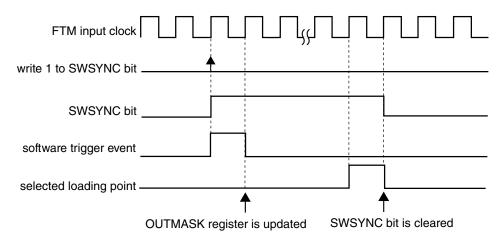


Figure 39-55. OUTMASK synchronization with (SYNCMODE = 0), (SYNCHOM = 1), (PWMSYNC = 0) and software trigger was used

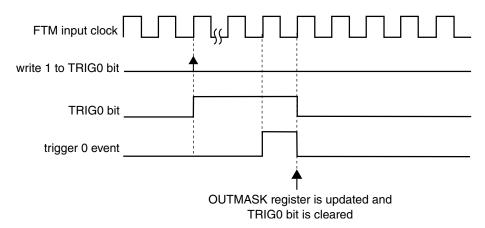


Figure 39-56. OUTMASK synchronization with (SYNCMODE = 0), (HWTRIGMODE = 0), (SYNCHOM = 1), (PWMSYNC = 0), and a hardware trigger was used

If (SYNCMODE = 0), (SYNCHOM = 1), and (PWMSYNC = 1), then this synchronization is made on the next enabled hardware trigger. The TRIGn bit is cleared according to Hardware trigger. An example with a hardware trigger follows.

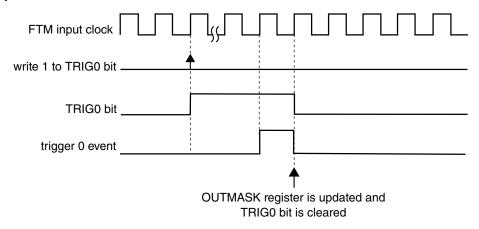


Figure 39-57. OUTMASK synchronization with (SYNCMODE = 0), (HWTRIGMODE = 0), (SYNCHOM = 1), (PWMSYNC = 1), and a hardware trigger was used

39.5.12.8 INVCTRL register synchronization

The INVCTRL register synchronization updates the INVCTRL register with its buffer value.

The INVCTRL register can be updated at each rising edge of FTM input clock (INVC = 0) or by the enhanced PWM synchronization (INVC = 1 and SYNCMODE = 1) according to the following flowchart.

In the case of enhanced PWM synchronization, the INVCTRL register synchronization depends on SWINVC and HWINVC bits.

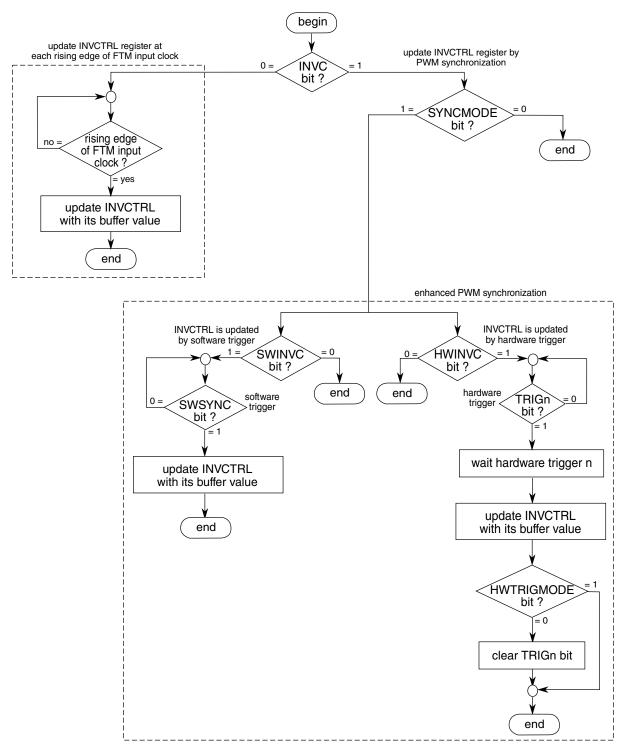


Figure 39-58. INVCTRL register synchronization flowchart

39.5.12.9 **SWOCTRL** register synchronization

The SWOCTRL register synchronization updates the SWOCTRL register with its buffer value.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

The SWOCTRL register can be updated at each rising edge of FTM input clock (SWOC = 0) or by the enhanced PWM synchronization (SWOC = 1 and SYNCMODE = 1) according to the following flowchart.

In the case of enhanced PWM synchronization, the SWOCTRL register synchronization depends on SWSOC and HWSOC bits.

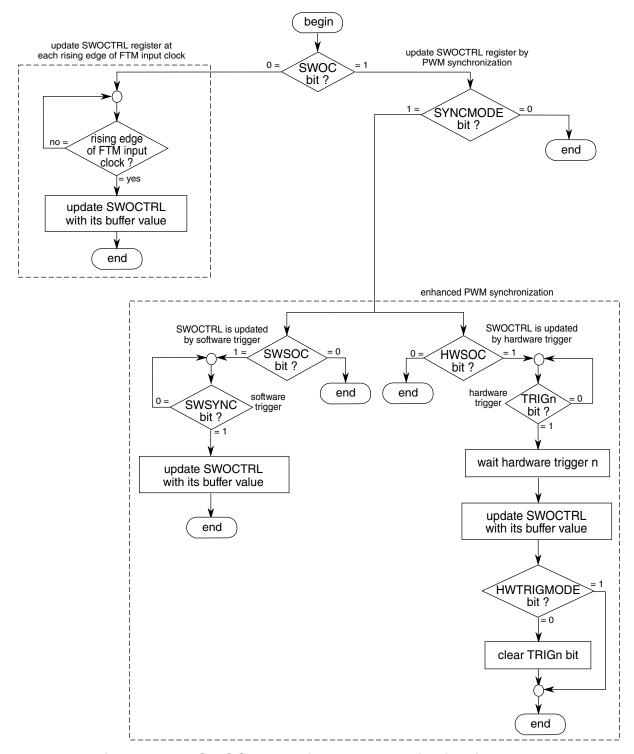


Figure 39-59. SWOCTRL register synchronization flowchart

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

39.5.12.10 FTM counter synchronization

The FTM counter synchronization is a mechanism that allows the FTM to restart the PWM generation at a certain point in the PWM period. The channels outputs are forced to their initial value, except for channels in Output Compare mode, and the FTM counter is forced to its initial counting value defined by CNTIN register.

The following figure shows the FTM counter synchronization. Note that after the synchronization event occurs, the channel (n) is set to its initial value and the channel (n +1) is not set to its initial value due to a specific timing of this figure in which the deadtime insertion prevents this channel output from transitioning to 1. If no deadtime insertion is selected, then the channel (n+1) transitions to logical value 1 immediately after the synchronization event occurs.

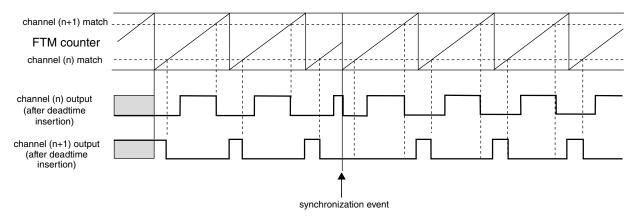


Figure 39-60. FTM counter synchronization

The FTM counter synchronization can be done by either the enhanced PWM synchronization (SYNCMODE = 1) or the legacy PWM synchronization (SYNCMODE = 0). However, the FTM counter must be synchronized only by the enhanced PWM synchronization.

In the case of enhanced PWM synchronization, the FTM counter synchronization depends on SWRSTCNT and HWRSTCNT bits according to the following flowchart.

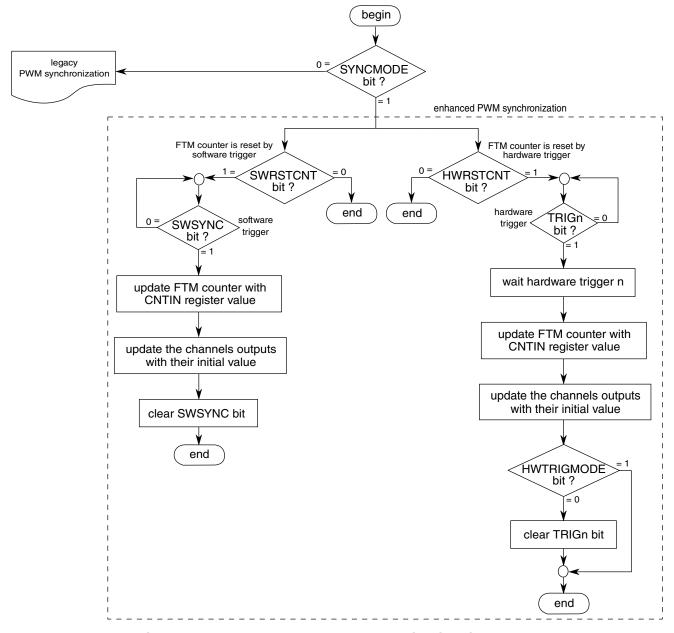
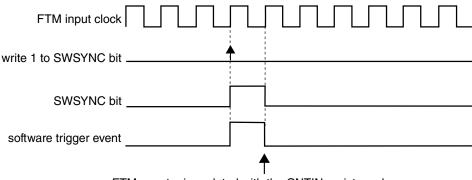


Figure 39-61. FTM counter synchronization flowchart

In the case of legacy PWM synchronization, the FTM counter synchronization depends on REINIT and PWMSYNC bits according to the following description.

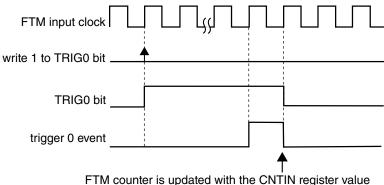
If (SYNCMODE = 0), (REINIT = 1), and (PWMSYNC = 0) then this synchronization is made on the next enabled trigger event. If the trigger event was a software trigger then the SWSYNC bit is cleared according to the following example. If the trigger event was a hardware trigger then the TRIGn bit is cleared according to Hardware trigger. Examples with software and hardware triggers follow.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018



FTM counter is updated with the CNTIN register value and channel outputs are forced to their initial value

Figure 39-62. FTM counter synchronization with (SYNCMODE = 0), (REINIT = 1), (PWMSYNC = 0), and software trigger was used



FIM counter is updated with the CNTIN register value and channel outputs are forced to their initial value

Figure 39-63. FTM counter synchronization with (SYNCMODE = 0), (HWTRIGMODE = 0), (REINIT = 1), (PWMSYNC = 0), and a hardware trigger was used

If (SYNCMODE = 0), (REINIT = 1), and (PWMSYNC = 1) then this synchronization is made on the next enabled hardware trigger. The TRIGn bit is cleared according to Hardware trigger.

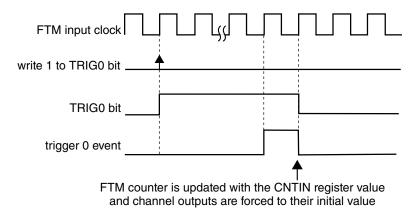


Figure 39-64. FTM counter synchronization with (SYNCMODE = 0), (HWTRIGMODE = 0), (REINIT = 1), (PWMSYNC = 1), and a hardware trigger was used

39.5.13 Inverting

The invert functionality swaps the signals between channel (n) and channel (n+1) outputs. The inverting operation is selected when:

- QUADEN = 0
- DECAPEN = 0
- COMP = 1, and
- INVm = 1 (where m represents a channel pair)

INV(m) bit selects the inverting to the pair channels (n) and (n+1).

The INVm bit in INVCTRL register is updated with its buffer value according to INVCTRL register synchronization

In High-True (ELSB:ELSA = 1:0) Combine mode, the channel (n) output is forced low at the beginning of the period (FTM counter = CNTIN), forced high at the channel (n) match and forced low at the channel (n+1) match. If the inverting is selected, the channel (n) output behavior is changed to force high at the beginning of the PWM period, force low at the channel (n) match and force high at the channel (n+1) match. See the following figure.

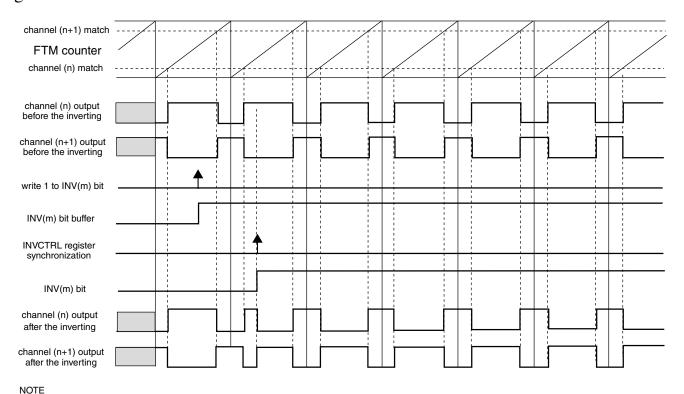
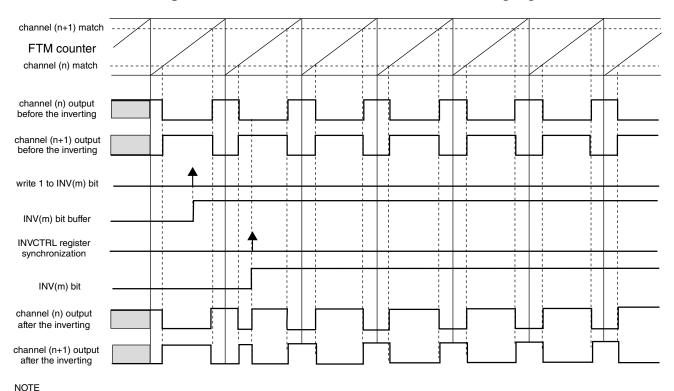


Figure 39-65. Channels (n) and (n+1) outputs after the inverting in High-True (ELSB:ELSA = 1:0) Combine mode

Note that the ELSB:ELSA bits value should be considered because they define the active state of the channels outputs. In Low-True (ELSB:ELSA = X:1) Combine mode, the channel (n) output is forced high at the beginning of the period, forced low at the channel (n) match and forced high at the channel (n+1) match. When inverting is selected, the channels (n) and (n+1) present waveforms as shown in the following figure.



INV(m) bit selects the inverting to the pair channels (n) and (n+1).

Figure 39-66. Channels (n) and (n+1) outputs after the inverting in Low-True (ELSB:ELSA = X:1) Combine mode

NOTE

The Inverting is not available in Output Compare mode.

39.5.14 Software Output Control Mode

The software output control forces the channel output according to software defined values at a specific time in the PWM generation.

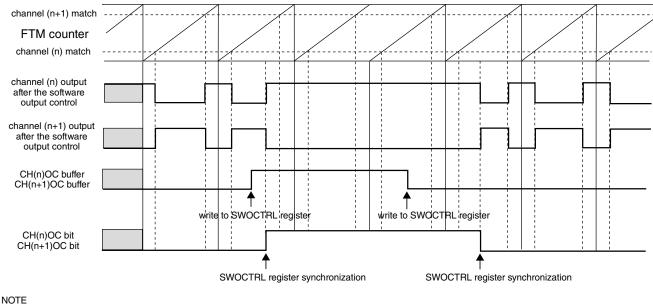
The software output control is selected when:

- QUADEN = 0
- DECAPEN = 0, and
- CH(n)OC = 1

The CH(n)OC bit enables the software output control for a specific channel output and the CH(n)OCV selects the value that is forced to this channel output.

Both CH(n)OC and CH(n)OCV bits in SWOCTRL register are buffered and updated with their buffer value according to SWOCTRL register synchronization.

The following figure shows the channels (n) and (n+1) outputs signals when the software output control is used. In this case the channels (n) and (n+1) are set to Combine and Complementary mode.



NOTE CH(n)OCV = 1 and CH(n+1)OCV = 0.

Figure 39-67. Example of software output control in Combine and Complementary mode

Software output control forces the following values on channels (n) and (n+1) when the COMP bit is zero.

CH(n)OC	CH(n+1)OC	CH(n)OCV	CH(n+1)OCV	Channel (n) Output	Channel (n+1) Output
0	0	Х	X	is not modified by SWOC	is not modified by SWOC
1	1	0	0	is forced to zero	is forced to zero
1	1	0	1	is forced to zero	is forced to one
1	1	1	0	is forced to one	is forced to zero
1	1	1	1	is forced to one	is forced to one

Table 39-10. Software outure control behavior when (COMP = 0)

Software output control forces the following values on channels (n) and (n+1) when the COMP bit is one.

Table 39-11. Soft	tware ouput control be	ehavior when (0	COMP = 1)
-------------------	------------------------	-----------------	-----------

CH(n)OC	CH(n+1)OC	CH(n)OCV	CH(n+1)OCV	Channel (n) Output	Channel (n+1) Output
0	0	Х	X	is not modified by SWOC	is not modified by SWOC
1	1	0	0	is forced to zero	is forced to zero
1	1	0	1	is forced to zero	is forced to one
1	1	1	0	is forced to one	is forced to zero
1	1	1	1	is forced to one	is forced to zero

Note

- The CH(n)OC and CH(n+1)OC bits should be equal.
- The COMP bit must not be modified when software output control is enabled, that is, CH(n)OC = 1 and/or CH(n +1)OC = 1.
- Software output control has the same behavior with disabled or enabled FTM counter (see the CLKS field description in the Status and Control register).

39.5.15 Deadtime insertion

The deadtime insertion is enabled when DTEN is set and DTVAL[5:0] is non-zero.

DEADTIME register defines the deadtime delay that can be used for all FTM channels. The clock for the DEADTIME delay is the FTM input clock divided by DTPS bits and the DTVAL[5:0] bits define the deadtime modulo, that is, the number of the deadtime prescaler clocks.

The deadtime delay insertion ensures that no two complementary signals (channels (n) and (n+1)) drive the active state at the same time.

If POL(n) = 0, POL(n+1) = 0, and the deadtime is enabled, then when the channel (n) match (FTM counter = C(n)V) occurs, the channel (n) output remains at the low value until the end of the deadtime delay when the channel (n) output is set. Similarly, when the channel (n+1) match (FTM counter = C(n+1)V) occurs, the channel (n+1) output remains at the low value until the end of the deadtime delay when the channel (n+1) output is set. See the following figures.

If POL(n) = 1, POL(n+1) = 1, and the deadtime is enabled, then when the channel (n) match (FTM counter = C(n)V) occurs, the channel (n) output remains at the high value until the end of the deadtime delay when the channel (n) output is cleared. Similarly,

when the channel (n+1) match (FTM counter = C(n+1)V) occurs, the channel (n+1) output remains at the high value until the end of the deadtime delay when the channel (n+1) output is cleared.

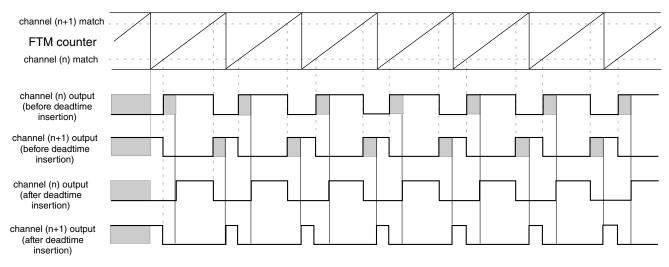


Figure 39-68. Deadtime insertion with ELSB:ELSA = 1:0, POL(n) = 0, and POL(n+1) = 0

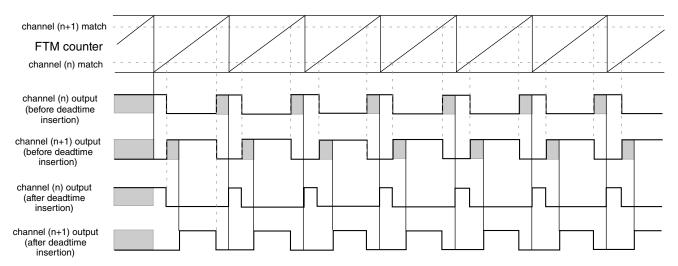


Figure 39-69. Deadtime insertion with ELSB:ELSA = X:1, POL(n) = 0, and POL(n+1) = 0

NOTE

- The deadtime feature must be used only in Complementary mode.
- The deadtime feature is not available in Output Compare mode.

39.5.15.1 Deadtime insertion corner cases

If (PS[2:0] is cleared), (DTPS[1:0] = 0:0 or DTPS[1:0] = 0:1):

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

- and the deadtime delay is greater than or equal to the channel (n) duty cycle ((C(n +1)V C(n)V) × FTM input clock), then the channel (n) output is always the inactive value (POL(n) bit value).
- and the deadtime delay is greater than or equal to the channel (n+1) duty cycle $((MOD CNTIN + 1 (C(n+1)V C(n)V)) \times FTM$ input clock), then the channel (n+1) output is always the inactive value (POL(n+1)) bit value).

Although, in most cases the deadtime delay is not comparable to channels (n) and (n+1) duty cycle, the following figures show examples where the deadtime delay is comparable to the duty cycle.

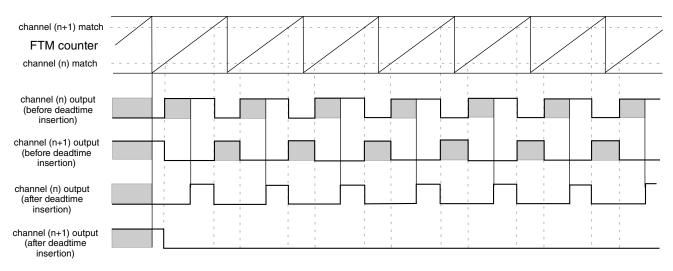


Figure 39-70. Example of the deadtime insertion (ELSB:ELSA = 1:0, POL(n) = 0, and POL(n+1) = 0) when the deadtime delay is comparable to channel (n+1) duty cycle

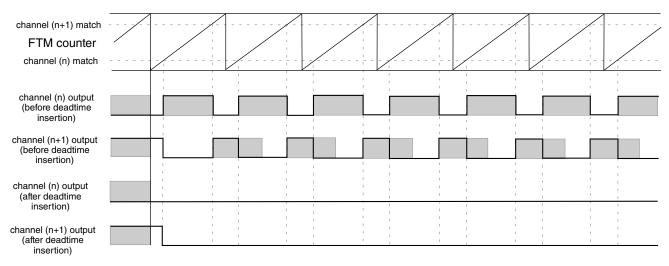


Figure 39-71. Example of the deadtime insertion (ELSB:ELSA = 1:0, POL(n) = 0, and POL(n+1) = 0) when the deadtime delay is comparable to channels (n) and (n+1) duty cycle

VD 0

39.5.16 Output mask

The output mask can be used to force channels output to their inactive state through software. For example: to control a BLDC motor.

Any write to the OUTMASK register updates its write buffer. The OUTMASK register is updated with its buffer value by PWM synchronization; see OUTMASK register synchronization.

If CH(n)OM = 1, then the channel (n) output is forced to its inactive state (POLn bit value). If CH(n)OM = 0, then the channel (n) output is unaffected by the output mask. See the following figure.

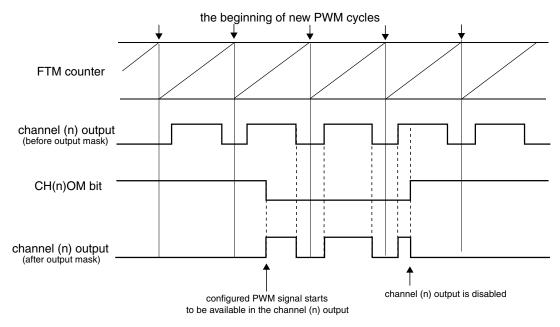


Figure 39-72. Output mask with POLn = 0

The following table shows the output mask result before the polarity control.

Table 39-12. Output mask result for channel (n) before the polarity control

CH(n)OM	Output Mask Input	Output Mask Result	
0	inactive state	inactive state	
	active state	active state	
1	inactive state	inactive state	
	active state		

39.5.17 Fault control

* where n = 3, 2, 1, 0

The fault control is enabled if $(FAULTM[1:0] \neq 0:0)$.

FTM can have up to four fault inputs. FAULTnEN bit (where n = 0, 1, 2, 3) enables the fault input n and FFLTRnEN bit enables the fault input n filter. FFVAL[3:0] bits select the value of the enabled filter in each enabled fault input.

First, each fault input signal is synchronized by the FTM input clock; see the synchronizer block in the following figure. Following synchronization, the fault input n signal enters the filter block. When there is a state change in the fault input n signal, the 5-bit counter is reset and starts counting up. As long as the new state is stable on the fault input n, the counter continues to increment. If the 5-bit counter overflows, that is, the counter exceeds the value of the FFVAL[3:0] bits, the new fault input n value is validated. It is then transmitted as a pulse edge to the edge detector.

If the opposite edge appears on the fault input n signal before validation (counter overflow), the counter is reset. At the next input transition, the counter starts counting again. Any pulse that is shorter than the minimum value selected by FFVAL[3:0] bits (× system clock) is regarded as a glitch and is not passed on to the edge detector.

The fault input n filter is disabled when the FFVAL[3:0] bits are zero or when FAULTnEN = 0. In this case, the fault input n signal is delayed 2 rising edges of the FTM input clock and the FAULTFn bit is set on 3th rising edge of the FTM input clock after a rising edge occurs on the fault input n.

If FFVAL[3:0] \neq 0000 and FAULTnEN = 1, then the fault input n signal is delayed (3 + FFVAL[3:0]) rising edges of the FTM input clock, that is, the FAULTFn bit is set (4 + FFVAL[3:0]) rising edges of the FTM input clock after a rising edge occurs on the fault input n.

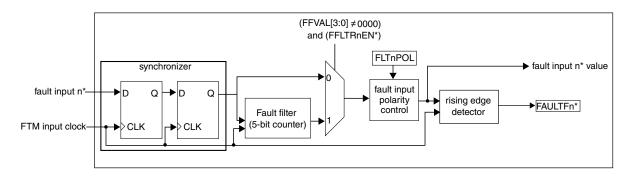


Figure 39-73. Fault input n control block diagram

If the fault control and fault input n are enabled and a rising edge at the fault input n signal is detected, a fault condition has occurred and the FAULTFn bit is set. The FAULTF bit is the logic OR of FAULTFn[3:0] bits. See the following figure.

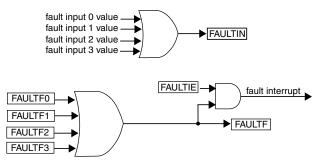


Figure 39-74. FAULTF and FAULTIN bits and fault interrupt

If the fault control is enabled (FAULTM[1:0] \neq 0:0), a fault condition has occurred and (FAULTEN = 1), then outputs are forced to their safe values:

- Channel (n) output takes the value of POL(n)
- Channel (n+1) takes the value of POL(n+1)

The fault interrupt is generated when (FAULTF = 1) and (FAULTIE = 1). This interrupt request remains set until:

- Software clears the FAULTF bit by reading FAULTF bit as 1 and writing 0 to it
- Software clears the FAULTIE bit.
- A reset occurs

39.5.17.1 Automatic fault clearing

If the automatic fault clearing is selected (FAULTM[1:0] = 1:1), then the channels output disabled by fault control is again enabled when the fault input signal (FAULTIN) returns to zero and a new PWM cycle begins. See the following figure.

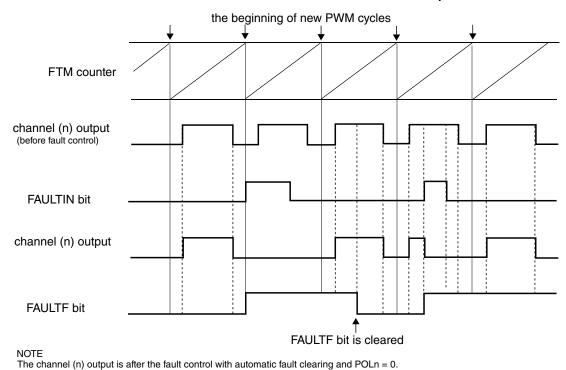
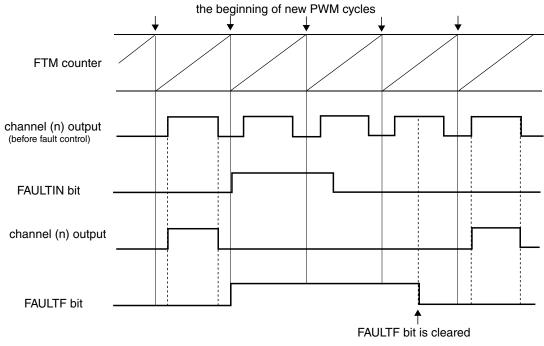


Figure 39-75. Fault control with automatic fault clearing

39.5.17.2 Manual fault clearing

If the manual fault clearing is selected (FAULTM[1:0] = 0:1 or 1:0), then the channels output disabled by fault control is again enabled when the FAULTF bit is cleared and a new PWM cycle begins. See the following figure.



NOTE
The channel (n) output is after the fault control with manual fault clearing and POLn = 0.

Figure 39-76. Fault control with manual fault clearing

39.5.17.3 Fault inputs polarity control

The FLTjPOL bit selects the fault input j polarity, where j = 0, 1, 2, 3:

- If FLTjPOL = 0, the fault j input polarity is high, so the logical one at the fault input j indicates a fault.
- If FLTjPOL = 1, the fault j input polarity is low, so the logical zero at the fault input j indicates a fault.

39.5.18 Polarity Control

The POLn bit selects the channel (n) output polarity:

- If POLn = 0, the channel (n) output polarity is high, so the logical one is the active state and the logical zero is the inactive state.
- If POLn = 1, the channel (n) output polarity is low, so the logical zero is the active state and the logical one is the inactive state.

Initialization 39.5.19

The initialization forces the CH(n)OI bit value to the channel (n) output when a one is written to the INIT bit.

The initialization depends on COMP and DTEN bits. The following table shows the values that channels (n) and (n+1) are forced by initialization when the COMP and DTEN bits are zero.

CH(n+1)OI CH(n)OI Channel (n) Output Channel (n+1) Output 0 0 is forced to zero is forced to zero 0 1 is forced to zero is forced to one 1 0 is forced to one is forced to zero 1 1 is forced to one is forced to one

Table 39-13. Initialization behavior when (COMP = 0)

The following table shows the values that channels (n) and (n+1) are forced by initialization when (COMP = 1) or (DTEN = 1).

Table 39-14. Initialization behavior when (COMP = 1 or DTEN = 1)

CH(n)OI	CH(n+1)OI	Channel (n) Output	Channel (n+1) Output
0	X	is forced to zero	is forced to one
1	X	is forced to one	is forced to zero

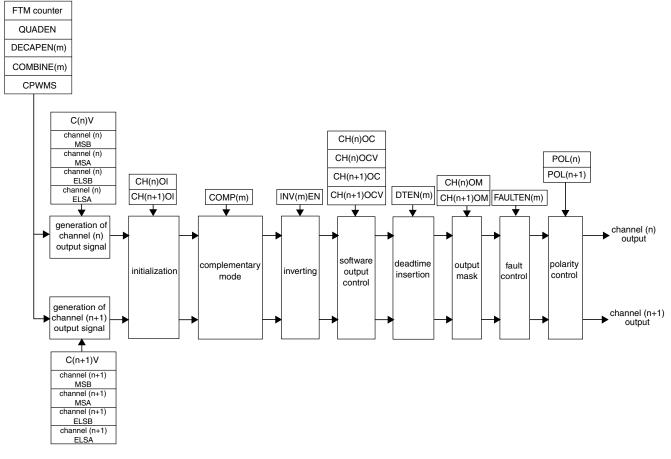
Note

The initialization feature must be used only with disabled FTM counter. See the description of the CLKS field in the Status and Control register.

Features priority 39.5.20

The following figure shows the priority of the features used at the generation of channels (n) and (n+1) outputs signals.

pair channels (m) - channels (n) and (n+1)



NOTE

The channels (n) and (n+1) are in Output Compare, EPWM, CPWM or Combine modes.

Figure 39-77. Priority of the features used at the generation of channels (n) and (n+1) output

NOTE

The Initialization must not be used with Inverting and Software Output Control Mode.

39.5.21 External Trigger

If the CH(j)TRIG bit of the External Trigger (FTM_EXTTRIG) register is set, where j = 0, 1, 2, 3, 4, 5, 6 or 7, then the FTM generates a trigger when the channel (j) match occurs (FTM counter = C(j)V).

The external trigger feature provides a trigger signal which has one FTM clock period width and is used for on-chip modules.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

The FTM is able to generate multiple triggers in one PWM period. Because each trigger is generated for a specific channel, several channels are required to implement this functionality. This behavior is described in Figure 39-78.

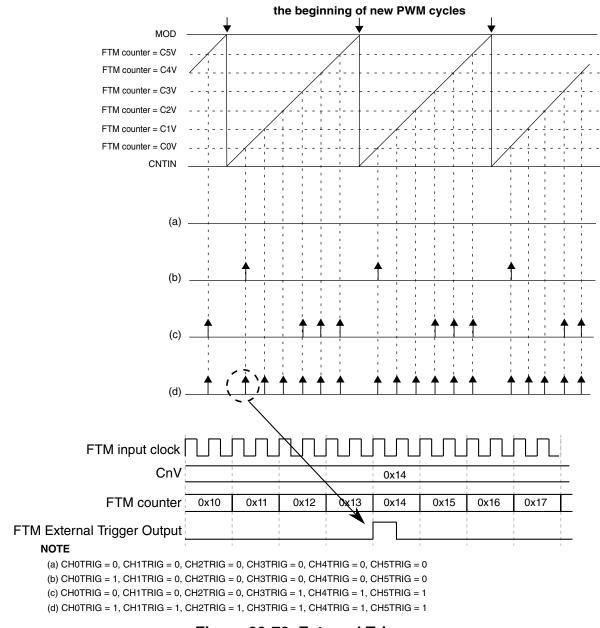


Figure 39-78. External Trigger

39.5.22 Channel trigger output

The channel trigger output provides a trigger signal which has one FTM clock period width in the channel output signal.

If the TRIGMODE bit of the CnSC register is set (TRIGMODE=1), a trigger pulse with one FTM clock cycle width is generated in the channel output when a match occurs. It is only allowed to use trigger mode when channel is in EPWM (up counting) or CPWM (up-down counting).

The figures below show some cases of trigger generation in a channel output.

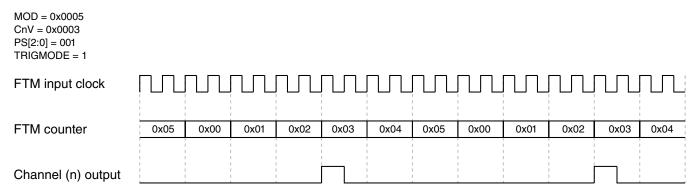


Figure 39-79. Example of trigger generation in the output channel for up counting mode

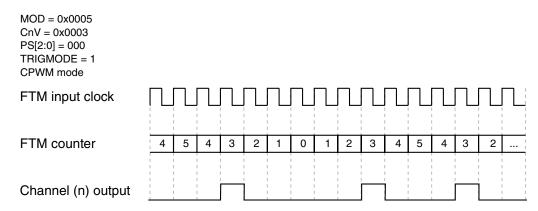


Figure 39-80. Example of trigger generation in the output channel for up-down counting mode

39.5.23 Initialization trigger

Initialization trigger allows FTM to generate an external trigger in some specific points of FTM counter cycle. This feature is controlled by two bits. INITTRIGEN enables the trigger generation and the ITRIGR selects in which events the initialization trigger should be generated. If INITTRIGEN = 1 and ITRIGR = 1, then the initialization trigger is generated when FTM counter reaches a reload point considering the Load Frequency configuration. See the Reload Points for more details about reload points. If INITTRIGEN = 1 and ITRIGR = 0, then FTM generates a trigger when the FTM counter is updated with the CNTIN register value in the following cases:

• In all cycles that FTM counter is automatically updated with CNTIN register value.

- When there is a write to CNT register.
- When there is the FTM counter synchronization.
- If (CNT = CNTIN), (CLKS[1:0] = 0:0), and a value different from zero is written to CLKS[1:0] bits.
- If the channel (n) is in Input Capture mode, (ICRST = 1) and the selected input capture event occurs in the channel (n) input.

The following figures show these cases.

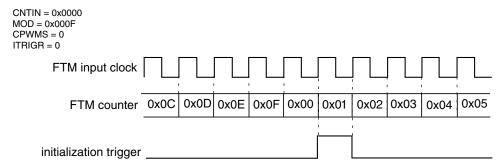


Figure 39-81. Initialization trigger is generated when the FTM counting achieves the CNTIN register value and ITRIGR = 0

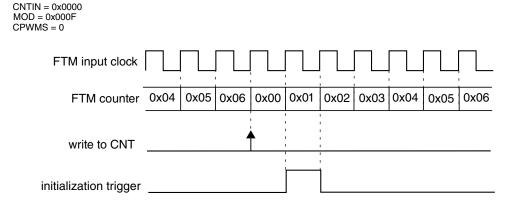


Figure 39-82. Initialization trigger is generated when there is a write to CNT register

CNTIN = 0x0000 MOD = 0x000F CPWMS = 0

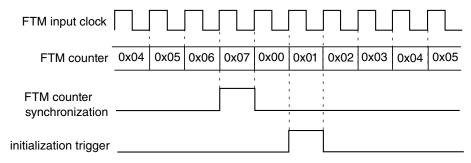


Figure 39-83. Initialization trigger is generated when there is the FTM counter synchronization

CNTIN = 0x0000 MOD = 0x000F CPWMS = 0

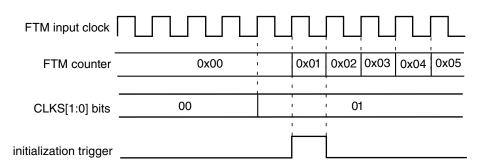


Figure 39-84. Initialization trigger is generated if (CNT = CNTIN), (CLKS[1:0] = 0:0), and a value different from zero is written to CLKS[1:0] bits

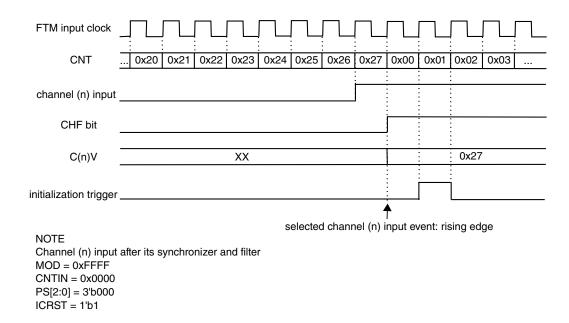


Figure 39-85. Initialization trigger is generated if the channel (n) is in Input Capture mode, ICRST = 1 and the selected input capture event occurs in the channel (n) input

The initialization trigger output provides a trigger signal that is used for on-chip modules.

Note

 When FTM is in up-down count mode (CPWMS = 1), the initialization trigger can be generated according to loadpoints CNTMAX and CNTMIN at SYNC register if ITRIGR=1.

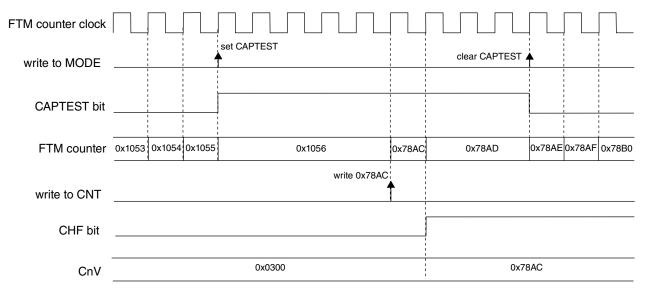
39.5.24 Capture Test Mode

The Capture Test mode allows to test the CnV registers, the FTM counter and the interconnection logic between the FTM counter and CnV registers.

In this test mode, all channels must be configured for Input Capture mode and FTM counter must be configured to the Up counting.

When the Capture Test mode is enabled (CAPTEST = 1), the FTM counter is frozen and any write to CNT register updates directly the FTM counter; see the following figure. After it was written, all CnV registers are updated with the written value to CNT register and CHF bits are set. Therefore, the FTM counter is updated with its next value according to its configuration. Its next value depends on CNTIN, MOD, and the written value to FTM counter.

The next reads of CnV registers return the written value to the FTM counter and the next reads of CNT register return FTM counter next value.



NOTE

- FTM counter is free running and (FTMEN = 1);
- FTM channel (n) is in Input Capture Mode.

Figure 39-86. Capture Test Mode

39.5.25 DMA

The channel generates a DMA transfer request according to DMA and CHIE bits. See the following table.

DMA CHIE **Channel DMA Transfer Request Channel Interrupt** 0 0 The channel DMA transfer request is not The channel interrupt is not generated. generated. 0 The channel DMA transfer request is not The channel interrupt is generated if (CHF = 1). generated. 1 0 The channel DMA transfer request is not The channel interrupt is not generated. generated. The channel DMA transfer request is generated if The channel interrupt is not generated. 1 1 (CHF = 1).

Table 39-15. Channel DMA transfer request

If DMA = 1, the CHF bit is cleared either by channel DMA transfer done or reading CnSC while CHF is set and then writing a zero to CHF bit according to CHIE bit. See the following table.

973

Table 39-16. Clear CHF bit when DMA = 1

CHIE	How CHF Bit Can Be Cleared
	CHF bit is cleared either when the channel DMA transfer is done or by reading CnSC while CHF is set and then writing a 0 to CHF bit.
1	CHF bit is cleared when the channel DMA transfer is done.

39.5.26 Dual Edge Capture mode

The Dual Edge Capture mode is selected if DECAPEN = 1. This mode allows to measure a pulse width or period of the signal on the input of channel (n) of a channel pair. The channel (n) filter can be active in this mode when n is 0 or 2.

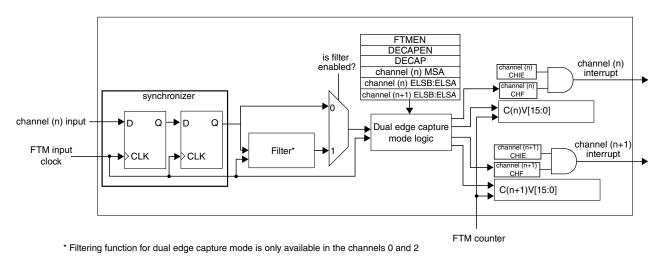


Figure 39-87. Dual Edge Capture mode block diagram

The channel (n) MSA bit defines if the Dual Edge Capture mode is one-shot or continuous.

The channel (n) ELSB:ELSA bits select the edge that is captured by channel (n), and channel (n+1) ELSB:ELSA bits select the edge that is captured by channel (n+1). If both channel (n) ELSB:ELSA and channel (n+1) ELSB:ELSA bits select the same edge, then it is the period measurement. If these bits select different edges, then it is a pulse width measurement.

In the Dual Edge Capture mode, only channel (n) input is used and channel (n+1) input is ignored.

If the selected edge by channel (n) bits is detected at channel (n) input, then channel (n) CHF bit is set and the channel (n) interrupt is generated (if channel (n) CHIE = 1). If the selected edge by channel (n+1) bits is detected at channel (n) input and (channel (n) CHF = 1), then channel (n+1) CHF bit is set and the channel (n+1) interrupt is generated (if channel (n+1) CHIE = 1).

The C(n)V register stores the value of FTM counter when the selected edge by channel (n) is detected at channel (n) input. The C(n+1)V register stores the value of FTM counter when the selected edge by channel (n+1) is detected at channel (n) input.

In this mode, a coherency mechanism ensures coherent data when the C(n)V and C(n+1)V registers are read. The only requirement is that C(n)V must be read before C(n+1)V.

Note

- The channel (n)n CHF, channel (n) CHIE, channel (n) MSA, channel (n) ELSB, and channel (n) ELSA bits are channel (n) bits.
- The channel (n+1) CHF, channel (n+1) CHIE, channel (n+1) MSA, channel (n+1) ELSB, and channel (n+1) ELSA bits are channel (n+1) bits.
- The Dual Edge Capture mode must be used with channel (n) ELSB:ELSA = 0:1 or 1:0, channel (n+1) ELSB:ELSA = 0:1 or 1:0 and the FTM counter in Free running counter.

39.5.26.1 One-Shot Capture mode

The One-Shot Capture mode is selected when (DECAPEN = 1), and (channel (n) MSA = 0). In this capture mode, only one pair of edges at the channel (n) input is captured. The channel (n) ELSB:ELSA bits select the first edge to be captured, and channel (n+1) ELSB:ELSA bits select the second edge to be captured.

The edge captures are enabled while DECAP bit is set. For each new measurement in One-Shot Capture mode, first the channel (n) CHF and channel (n+1) CHF bits must be cleared, and then the DECAP bit must be set.

In this mode, the DECAP bit is automatically cleared by FTM when the edge selected by channel (n+1) is captured. Therefore, while DECAP bit is set, the one-shot capture is in process. When this bit is cleared, both edges were captured and the captured values are ready for reading in the C(n)V and C(n+1)V registers.

Similarly, when the channel (n+1) CHF bit is set, both edges were captured and the captured values are ready for reading in the C(n)V and C(n+1)V registers.

39.5.26.2 Continuous Capture mode

The Continuous Capture mode is selected when (DECAPEN = 1), and (channel (n) MSA = 1). In this capture mode, the edges at the channel (n) input are captured continuously. The channel (n) ELSB:ELSA bits select the initial edge to be captured, and channel (n+1) ELSB:ELSA bits select the final edge to be captured.

The edge captures are enabled while DECAP bit is set. For the initial use, first the channel (n) CHF and channel (n+1) CHF bits must be cleared, and then DECAP bit must be set to start the continuous measurements.

When the channel (n+1) CHF bit is set, both edges were captured and the captured values are ready for reading in the C(n)V and C(n+1)V registers. The latest captured values are always available in these registers even after the DECAP bit is cleared.

In this mode, it is possible to clear only the channel (n+1) CHF bit. Therefore, when the channel (n+1) CHF bit is set again, the latest captured values are available in C(n)V and C(n+1)V registers.

For a new sequence of the measurements in the Dual Edge Capture – Continuous mode, clear the channel (n) CHF and channel (n+1) CHF bits to start new measurements.

39.5.26.3 Pulse width measurement

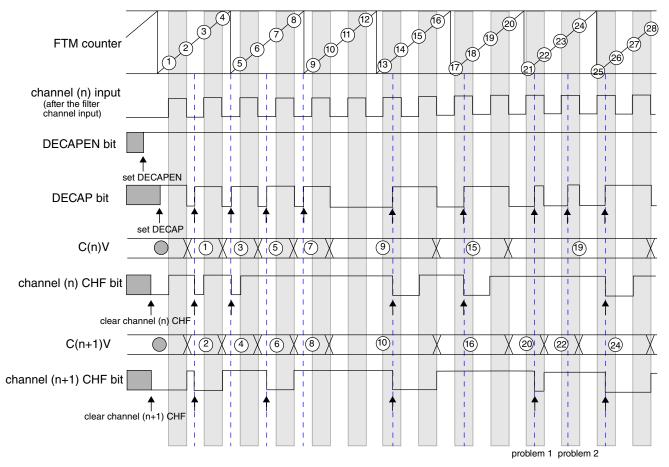
If the channel (n) is configured to capture rising edges (channel (n) ELSB:ELSA = 0:1) and the channel (n+1) to capture falling edges (channel (n+1) ELSB:ELSA = 1:0), then the positive polarity pulse width is measured. If the channel (n) is configured to capture falling edges (channel (n) ELSB:ELSA = 1:0) and the channel (n+1) to capture rising edges (channel (n+1) ELSB:ELSA = 0:1), then the negative polarity pulse width is measured.

The pulse width measurement can be made in One-Shot Capture mode or Continuous Capture mode.

The following figure shows an example of the Dual Edge Capture – One-Shot mode used to measure the positive polarity pulse width. The DECAPEN bit selects the Dual Edge Capture mode, so it remains set. The DECAP bit is set to enable the measurement of next positive polarity pulse width. The channel (n) CHF bit is set when the first edge of this pulse is detected, that is, the edge selected by channel (n) ELSB:ELSA bits. The channel (n+1) CHF bit is set and DECAP bit is cleared when the second edge of this pulse is

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

detected, that is, the edge selected by channel (n+1) ELSB:ELSA bits. Both DECAP and channel (n+1) CHF bits indicate when two edges of the pulse were captured and the C(n)V and C(n+1)V registers are ready for reading.

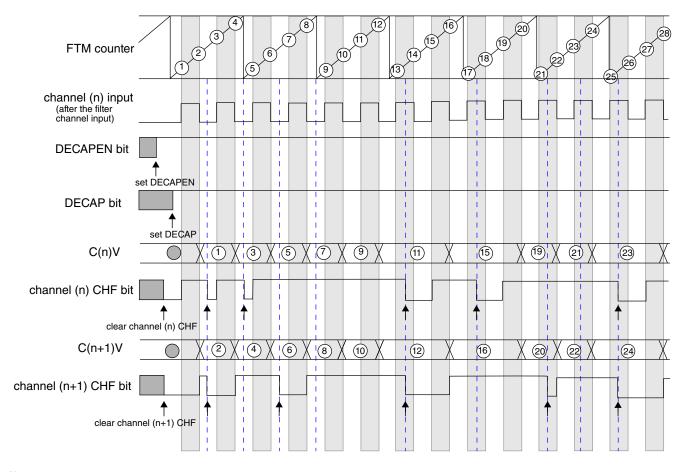


Note

- The commands set DECAPEN, set DECAP, clear channel (n) CHF, and clear channel (n+1) CHF are made by the user.
- Problem 1: channel (n) input = 1, set DECAP, not clear channel (n) CHF, and clear channel (n+1) CHF.
- Problem 2: channel (n) input = 1, set DECAP, not clear channel (n) CHF, and not clear channel (n+1) CHF.

Figure 39-88. Dual Edge Capture – One-Shot mode for positive polarity pulse width measurement

The following figure shows an example of the Dual Edge Capture – Continuous mode used to measure the positive polarity pulse width. The DECAPEN bit selects the Dual Edge Capture mode, so it remains set. While the DECAP bit is set the configured measurements are made. The channel (n) CHF bit is set when the first edge of the positive polarity pulse is detected, that is, the edge selected by channel (n) ELSB:ELSA bits. The channel (n+1) CHF bit is set when the second edge of this pulse is detected, that is, the edge selected by channel (n+1) ELSB:ELSA bits. The channel (n+1) CHF bit indicates when two edges of the pulse were captured and the C(n)V and C(n+1)V registers are ready for reading.



Note

Figure 39-89. Dual Edge Capture – Continuous mode for positive polarity pulse width measurement

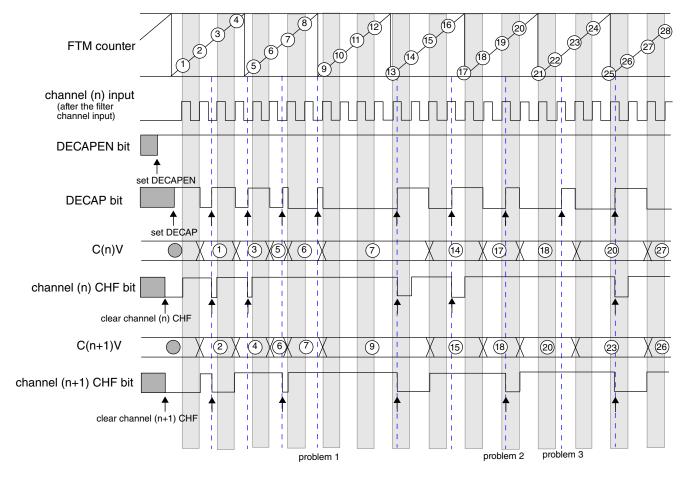
39.5.26.4 Period measurement

If the channels (n) and (n+1) are configured to capture consecutive edges of the same polarity, then the period of the channel (n) input signal is measured. If both channels (n) and (n+1) are configured to capture rising edges (channel (n) ELSB:ELSA = 0:1 and channel (n+1) ELSB:ELSA = 0:1), then the period between two consecutive rising edges is measured. If both channels (n) and (n+1) are configured to capture falling edges (channel (n) ELSB:ELSA = 1:0) and channel (n+1) ELSB:ELSA = 1:0), then the period between two consecutive falling edges is measured.

The period measurement can be made in One-Shot Capture mode or Continuous Capture mode.

⁻ The commands set DECAPEN, set DECAP, clear channel (n) CHF, and clear channel (n+1) CHF are made by the user.

The following figure shows an example of the Dual Edge Capture – One-Shot mode used to measure the period between two consecutive rising edges. The DECAPEN bit selects the Dual Edge Capture mode, so it remains set. The DECAP bit is set to enable the measurement of next period. The channel (n) CHF bit is set when the first rising edge is detected, that is, the edge selected by channel (n) ELSB:ELSA bits. The channel (n+1) CHF bit is set and DECAP bit is cleared when the second rising edge is detected, that is, the edge selected by channel (n+1) ELSB:ELSA bits. Both DECAP and channel (n+1) CHF bits indicate when two selected edges were captured and the C(n)V and C(n+1)V registers are ready for reading.



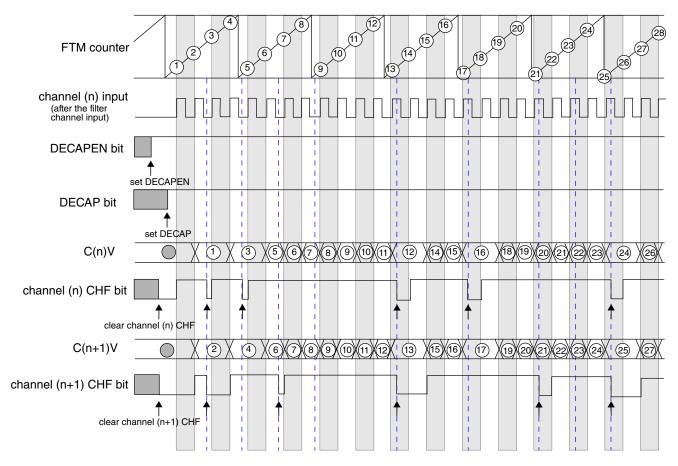
Note

- The commands set DECAPEN, set DECAP, clear channel (n) CHF, and clear channel (n+1) CHF are made by the user.
- Problem 1: channel (n) input = 0, set DECAP, not clear channel (n) CHF, and not clear channel (n+1) CHF.
- Problem 2: channel (n) input = 1, set DECAP, not clear channel (n) CHF, and clear channel (n+1) CHF.
- Problem 3: channel (n) input = 1, set DECAP, not clear channel (n) CHF, and not clear channel (n+1) CHF.

Figure 39-90. Dual Edge Capture – One-Shot mode to measure of the period between two consecutive rising edges

The following figure shows an example of the Dual Edge Capture – Continuous mode used to measure the period between two consecutive rising edges. The DECAPEN bit selects the Dual Edge Capture mode, so it remains set. While the DECAP bit is set the configured measurements are made. The channel (n) CHF bit is set when the first rising

edge is detected, that is, the edge selected by channel (n) ELSB:ELSA bits. The channel (n+1) CHF bit is set when the second rising edge is detected, that is, the edge selected by channel (n+1) ELSB:ELSA bits. The channel (n+1) CHF bit indicates when two edges of the period were captured and the C(n)V and C(n+1)V registers are ready for reading.



Note

Figure 39-91. Dual Edge Capture – Continuous mode to measure of the period between two consecutive rising edges

39.5.26.5 Read coherency mechanism

The Dual Edge Capture mode implements a read coherency mechanism between the FTM counter value captured in C(n)V and C(n+1)V registers. The read coherency mechanism is illustrated in the following figure. In this example, the channels (n) and (n +1) are in Dual Edge Capture – Continuous mode for positive polarity pulse width measurement. Thus, the channel (n) is configured to capture the FTM counter value when there is a rising edge at channel (n) input signal, and channel (n+1) to capture the FTM counter value when there is a falling edge at channel (n) input signal.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

⁻ The commands set DECAPEN, set DECAP, clear channel (n) CHF, and clear channel (n+1) CHF are made by the user.

When a rising edge occurs in the channel (n) input signal, the FTM counter value is captured into channel (n) capture buffer. The channel (n) capture buffer value is transferred to C(n)V register when a falling edge occurs in the channel (n) input signal. C(n)V register has the FTM counter value when the previous rising edge occurred, and the channel (n) capture buffer has the FTM counter value when the last rising edge occurred.

When a falling edge occurs in the channel (n) input signal, the FTM counter value is captured into channel (n+1) capture buffer. The channel (n+1) capture buffer value is transferred to C(n+1)V register when the C(n)V register is read.

In the following figure, the read of C(n)V returns the FTM counter value when the event 1 occurred and the read of C(n+1)V returns the FTM counter value when the event 2 occurred.

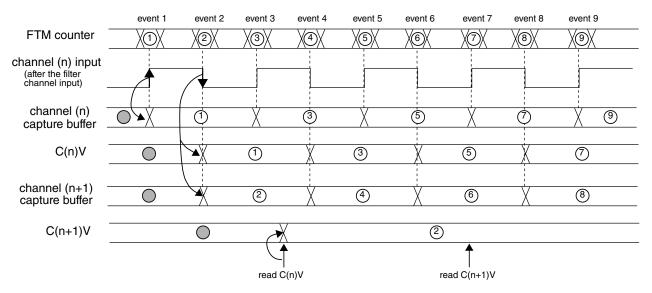


Figure 39-92. Dual Edge Capture mode read coherency mechanism

C(n)V register must be read prior to C(n+1)V register in dual edge capture one-shot and continuous modes for the read coherency mechanism works properly.

Quadrature Decoder mode 39.5.27

The Quadrature Decoder mode is selected if (QUADEN = 1). The Quadrature Decoder mode uses the input signals phase A and B to control the FTM counter increment and decrement. The following figure shows the quadrature decoder block diagram.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018 980 NXP Semiconductors

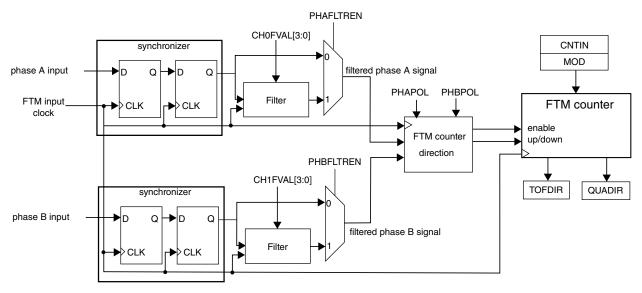


Figure 39-93. Quadrature Decoder block diagram

Each one of input signals phase A and B has a filter that is equivalent to the filter used in the channels input; Filter for Input Capture mode. The phase A input filter is enabled by PHAFLTREN bit and this filter's value is defined by CH0FVAL[3:0] bits (CH(n)FVAL[3:0] bits in FILTER0 register). The phase B input filter is enabled by PHBFLTREN bit and this filter's value is defined by CH1FVAL[3:0] bits (CH(n+1)FVAL[3:0] bits in FILTER0 register).

Except for CH0FVAL[3:0] and CH1FVAL[3:0] bits, no channel logic is used in Quadrature Decoder mode.

Note

Notice that the FTM counter is clocked by the phase A and B input signals when quadrature decoder mode is selected. Therefore it is expected that the Quadrature Decoder be used only with the FTM channels in input capture or output compare modes.

Note

An edge at phase A must not occur together an edge at phase B and vice-versa.

The PHAPOL bit selects the polarity of the phase A input, and the PHBPOL bit selects the polarity of the phase B input.

The QUADMODE selects the encoding mode used in the Quadrature Decoder mode. If QUADMODE = 1, then the count and direction encoding mode is enabled; see the following figure. In this mode, the phase B input value indicates the counting direction, and the phase A input defines the counting rate. The FTM counter is updated when there is a rising edge at phase A input signal.

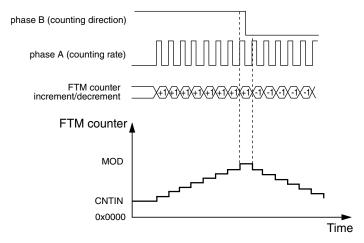


Figure 39-94. Quadrature Decoder – Count and Direction Encoding mode

If QUADMODE = 0, then the Phase A and Phase B Encoding mode is enabled; see the following figure. In this mode, the relationship between phase A and B signals indicates the counting direction, and phase A and B signals define the counting rate. The FTM counter is updated when there is an edge either at the phase A or phase B signals.

If PHAPOL = 0 and PHBPOL = 0, then the FTM counter increment happens when:

- there is a rising edge at phase A signal and phase B signal is at logic zero;
- there is a rising edge at phase B signal and phase A signal is at logic one;
- there is a falling edge at phase B signal and phase A signal is at logic zero;
- there is a falling edge at phase A signal and phase B signal is at logic one;

and the FTM counter decrement happens when:

- there is a falling edge at phase A signal and phase B signal is at logic zero;
- there is a falling edge at phase B signal and phase A signal is at logic one;
- there is a rising edge at phase B signal and phase A signal is at logic zero;
- there is a rising edge at phase A signal and phase B signal is at logic one.

NYP Semico

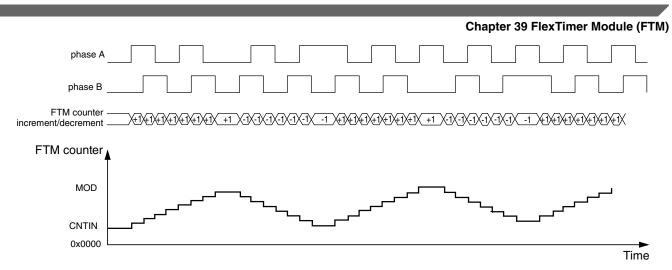


Figure 39-95. Quadrature Decoder - Phase A and Phase B Encoding mode

The following figure shows the FTM counter overflow in up counting. In this case, when the FTM counter changes from MOD to CNTIN, TOF and TOFDIR bits are set. TOF bit indicates the FTM counter overflow occurred. TOFDIR indicates the counting was up when the FTM counter overflow occurred.

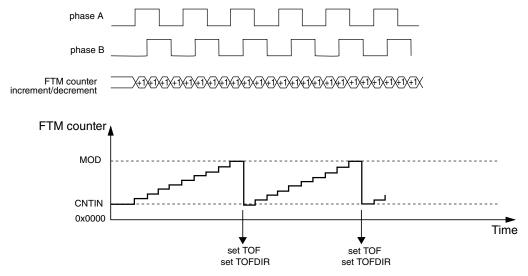


Figure 39-96. FTM Counter overflow in up counting for Quadrature Decoder mode

The following figure shows the FTM counter overflow in down counting. In this case, when the FTM counter changes from CNTIN to MOD, TOF bit is set and TOFDIR bit is cleared. TOF bit indicates the FTM counter overflow occurred. TOFDIR indicates the counting was down when the FTM counter overflow occurred.

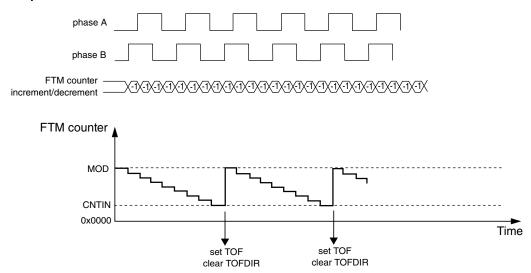


Figure 39-97. FTM counter overflow in down counting for Quadrature Decoder mode

39.5.27.1 Quadrature Decoder boundary conditions

The following figures show the FTM counter responding to motor jittering typical in motor position control applications.

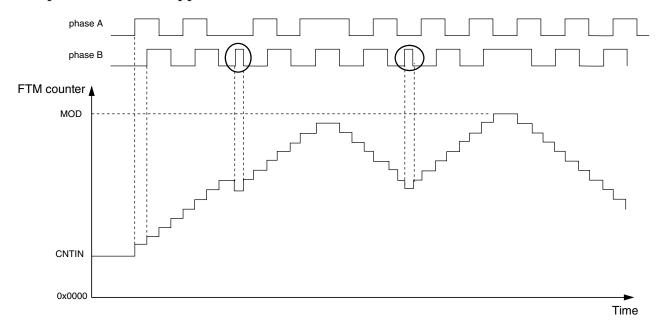


Figure 39-98. Motor position jittering in a mid count value

The following figure shows motor jittering produced by the phase B and A pulses respectively:

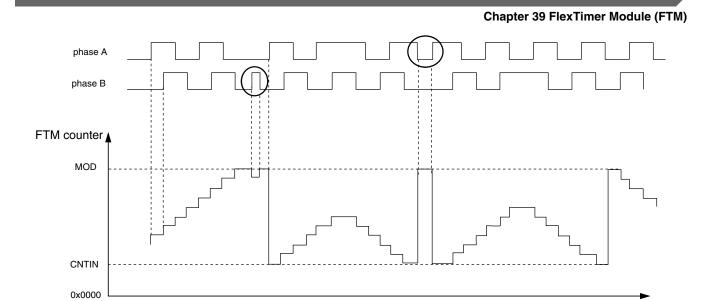


Figure 39-99. Motor position jittering near maximum and minimum count value

Time

The first highlighted transition causes a jitter on the FTM counter value near the maximum count value (MOD). The second indicated transition occurs on phase A and causes the FTM counter transition between the maximum and minimum count values which are defined by MOD and CNTIN registers.

The appropriate settings of the phase A and phase B input filters are important to avoid glitches that may cause oscillation on the FTM counter value. The preceding figures show examples of oscillations that can be caused by poor input filter setup. Thus, it is important to guarantee a minimum pulse width to avoid these oscillations.

39.5.28 Debug mode

When the chip is in Debug mode, the BDMMODE[1:0] bits select the behavior of the FTM counter, the channel (n) CHF bit, the channels output, and the writes to the MOD, CNTIN, and C(n)V registers according to the following table.

BDMMODE	FTM Counter	channel (n) CHF bit	FTM Channels Output	Writes to MOD, CNTIN, and C(n)V Registers
00	Stopped	can be set	Functional mode	Writes to these registers bypass the registers buffers
01	Stopped	is not set	The channels outputs are forced to their safe value according to POLn bit	Writes to these registers bypass the registers buffers
10	Stopped	is not set	The channels outputs are frozen when the chip enters in Debug mode	Writes to these registers bypass the registers buffers

Table 39-17. FTM behavior when the chip is in Debug mode

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Table 39-17. FTM behavior when the chip Is in Debug mode (continued)

BDMMODE	FTM Counter	channel (n) CHF bit	FTM Channels Output	Writes to MOD, CNTIN, and C(n)V Registers
11	Functional mode	can be set	Functional mode	Functional mode

Note that if BDMMODE[1:0] = 2'b00 then the channels outputs remain at the value when the chip enters in Debug mode, because the FTM counter is stopped. However, the following situations modify the channels outputs in this Debug mode.

- Write any value to CNT register; see Counter reset. In this case, the FTM counter is updated with the CNTIN register value and the channels outputs are updated to the initial value except for those channels set to Output Compare mode.
- FTM counter is reset by PWM Synchronization mode; see FTM counter synchronization. In this case, the FTM counter is updated with the CNTIN register value and the channels outputs are updated to the initial value except for channels in Output Compare mode.
- In the channels outputs initialization, the channel (n) output is forced to the CH(n)OI bit value when the value 1 is written to INIT bit. See Initialization.

Note

The BDMMODE[1:0] = 2'b00 must not be used with the Fault control. Even if the fault control is enabled and a fault condition exists, the channels outputs values are updated as above.

Note

If CLKS[1:0] = 2'b00 in BDM, a non-zero value is written to CLKS in BDM, and CnV = CNTIN when the BDM is disabled, then the CHF bit is set (since if the channel is a 0% EPWM signal) when the BDM is disabled.

39.5.29 Reload Points

The reload points are points where the registers MOD, CNTIN, C(n)V and HCR can be updated with their write buffer value.

There are multiple reload opportunities. Each reload opportunity can turn into a reload point or not according to the load frequency. For example, if the load frequency is zero, then any reload opportunity is also a reload point. Note that when a reload point is

reached, a register reload will only occur if LDOK bit is enabled. The reload flag (RF) and initialization trigger generation are independent of LDOK bit. The table below shows which are the reload opportunities.

Table 39-18. When possible reload opportunities are enabled

Loading point	Enabled
When a counter event happens. See Counter events.	Always
At the channel (j) match (FTM counter = C(j)V)	When CHjSEL = 1
At the Half cycle event match (FTM counter = HCR)	When HCSEL = 1

The figure below shows a simplified representation of the reload logic. The Reload Flag (RF) can be used to generate an external interrupt when a load point is reached. It is also possible to generate an initialization trigger and a register reload when a load point is reached. Note that Load Frequency configuration can modify the RF generation.

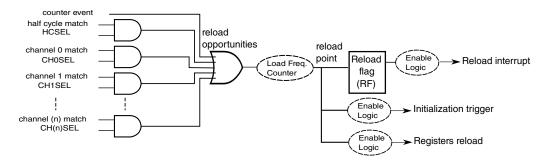


Figure 39-100. Registers reload logic

The following figure shows some examples of enabled reload opportunities when counter is in up counting mode. Note that the example below also uses a channel match as reload opportunity, but generally applications uses only the half cycle match if a non full cycle reload is needed.

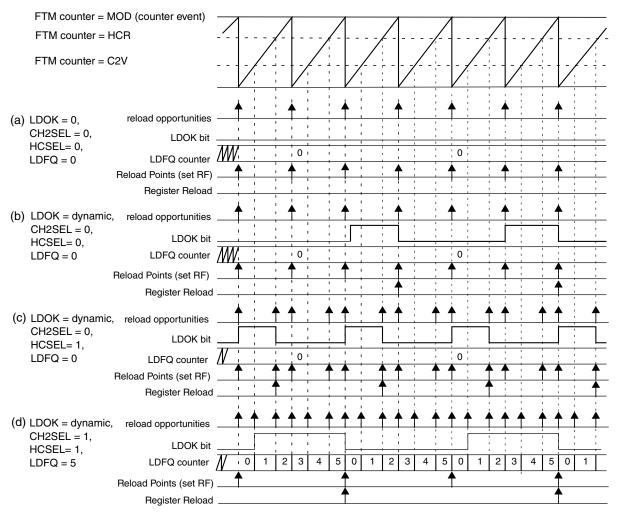


Figure 39-101. Reload opportunities to half and full cycle reload when up counting

The table below shows the possible counter events selection (reload opportunities) to updown counting mode:

Table 39-19. Reload opportunities to up-down counting mode

FTM_SYNC bits	Reload opportunities selected
CNTMIN = 0 and CNTMAX = 0	When the counter turns from up to down (compatibility mode).
CNTMIN = 1 and CNTMAX = 0	When the counter turns from down to up.
CNTMIN = 0 and CNTMAX = 1	When the counter turns from up to down.
CNTMIN = 1 and CNTMAX = 1	When the counter turns from down to up and When the counter turns from up to down.

After enabling the reload opportunities, the LDOK bit must be set for the reload to occur. In this case, the reload occurs at the next enabled reload point considering the Load Frequency according to the following conditions:

989

Table 39-20. Conditions for reload occurring at the next enabled reload point

When a new value was written	Then
To the MOD register	The MOD register is updated with its write buffer value.
To the HCR register	The HCR register is updated with its write buffer value.
To the CNTIN register and CNTINC = 1	The CNTIN register is updated with its write buffer value.
To the C(n)V register and SYNCENm = $1 - \text{where m indicates}$ the pair channels (n) and (n+1)	The C(n)V register is updated with its write buffer value.
To the C(n+1)V register and SYNCENm = 1 – where m indicates the pair channels (n) and (n+1)	The C(n+1)V register is updated with its write buffer value.

NOTE

The reload points feature is independent of the PWM synchronization.

At these reload points neither the channels outputs nor the FTM counter are changed. Software must select these reload points at the safe points in time.

Global Load 39.5.30

The global load mechanism allows several modules to have their double buffered registers synchronously reloaded after a synchronization event if a write to one operation is performed in the global load OK (GLDOK) bit in the FTM_PWMLOAD register. Global load may be enabled or disabled configuring the global load enable (GLEN) bit in the FTM PWMLOAD register. Writing one in the GLDOK bit with GLEN enabled has the same effect of writing one in the LDOK bit. Refer to SoC specific information about global load connections.

Global load mechanism allows MOD, HCR, CNTIN, and C(n)V registers to be updated with the content of the register buffer at configurable reload point. The figure below shows an example of connection between FTM global load inputs and outputs considering that GLDOK bit is implemented outside from FTM module.

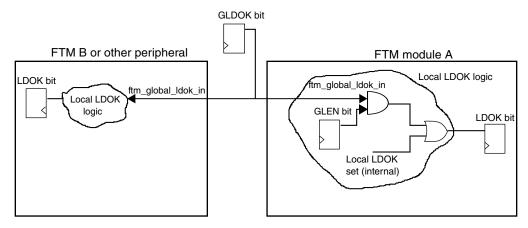


Figure 39-102. Global load logic

39.5.31 Global time base (GTB)

The global time base (GTB) is a FTM function that allows the synchronization of multiple FTM modules on a chip. The following figure shows an example of the GTB feature used to synchronize two FTM modules. In this case, the FTM A and B channels can behave as if just one FTM module was used, that is, a global time base.

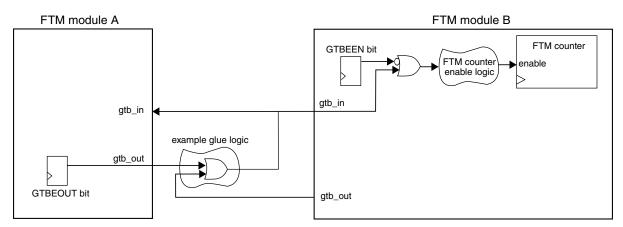


Figure 39-103. Global time base (GTB) block diagram

The GTB functionality is implemented by the GTBEEN and GTBEOUT bits in the CONF register, the input signal *gtb_in*, and the output signal *gtb_out*. The GTBEEN bit enables gtb_in to control the FTM counter enable signal:

- If GTBEEN = 0, each one of FTM modules works independently according to their configured mode.
- If GTBEEN = 1, the FTM counter update is enabled only when gtb_in is 1.

In the configuration described in the preceding figure, FTM modules A and B have their FTM counters enabled if at least one of the gtb_out signals from one of the FTM modules is 1. There are several possible configurations for the interconnection of the gtb_in and

991

gtb_out signals, represented by the example glue logic shown in the figure. Note that these configurations are chip-dependent and implemented outside of the FTM modules. See the chip-specific FTM information for the chip's specific implementation.

NOTE

- In order to use the GTB signals to synchronize the FTM counter of different FTM modules, the configuration of each FTM module should guarantee that its FTM counter starts counting as soon as the gtb_in signal is 1.
- The GTB feature does not provide continuous synchronization of FTM counters, meaning that the FTM counters may lose synchronization during FTM operation. The GTB feature only allows the FTM counters to *start* their operation synchronously.

39.5.31.1 Enabling the global time base (GTB)

To enable the GTB feature, follow these steps for each participating FTM module:

- 1. Stop the FTM counter: Write 00b to SC[CLKS].
- 2. Program the FTM to the intended configuration. The FTM counter mode needs to be consistent across all participating modules.
- 3. Write 1 to CONF[GTBEEN] and write 0 to CONF[GTBEOUT] at the same time.
- 4. Select the intended FTM counter clock source in SC[CLKS]. The clock source needs to be consistent across all participating modules.
- 5. Reset the FTM counter: Write any value to the CNT register.

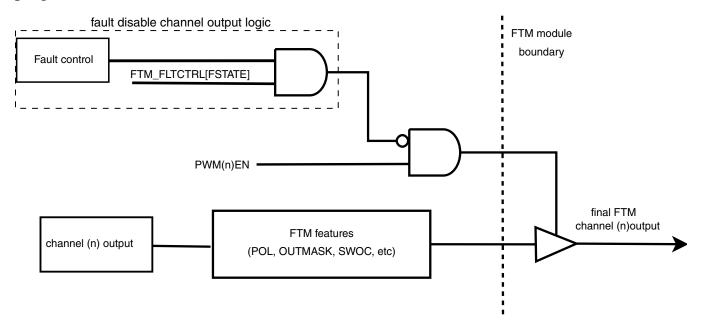
To initiate the GTB feature in the configuration described in the preceding figure, write 1 to CONF[GTBEOUT] in the FTM module used as the time base.

39.5.32 Output Logic

The following figure shows the output logic of each FTM channel output including how each PWM output has individual fault disabling and output enable. This allows flexibility regarding the external circuitry interface.

The output buffer logic depends on PWM_EN bit of FTM_SC register and fault disable channel output logic (see Fault control to more details). Channel outputs will be enabled only if PWM_EN is enabled and there is no fault event ongoing configured to tri-state the outputs by FSTATE bit at FTM_FLTCTRL register. Note that Polarity logic will act before channel enable logic. Therefore, it is imperative that the user program the channel

polarities before enabling the output pins. A fault condition can result in the PWM output being tristated, forced to a logic 1, or forced to a logic 0 depending on the values programmed into the POL, and FSTATE fields.



39.5.33 Dithering

FTM implements a fractional delay to achieve fine resolution on the generated PWM signals using dithering. The dithering can be used by applications where more resolution than one unit of the FTM counter is needed.

Two kinds of dithering are available: PWM period dithering and edge dithering.

39.5.33.1 PWM Period Dithering

The PWM period dithering is enabled when a non-zero value is written to FRACMOD.

The internal accumulator used in the PWM period dithering is reset when:

- the field MOD of the register MOD_MIRROR is updated with the value of its write buffer.
- the FRACMOD is updated with the value of its write buffer, or
- the FTM counter is stopped.

NOTE

For the PWM period dithering, the register MOD_MIRROR should be used instead of the register MOD.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

To avoid inconsistencies, the field FRACMOD is cleared when the field MOD of the register MOD is updated with the value of its write buffer.

The PWM period dithering is not available:

- when the FTM counter is a free running counter,
- when the FTM is in quadrature decoder mode.

Up Counting 39.5.33.1.1

When the FTM counter is an up counter and the PWM period dithering is enabled, at the end of each PWM period, the FRACMOD value is added to an internal 5-bit accumulator. When this accumulator overflows (that is, the result of the adding is greater or equal than 0x20), then one unit of FTM counter is added to the end of the current PWM period, and the accumulator remains with the rest of the subtraction: (the result of this adding - 0x20).

Due to one unit of FTM counter that can be added to the PWM period, the largest valid value for MOD is 0xFFFE for PWM period dithering with unsigned counting and 0x7FFE for PWM period dithering with signed counting.

The figure belows an examples of PWM period dithering when the FTM counter is an up counter.

NXP Semiconductors

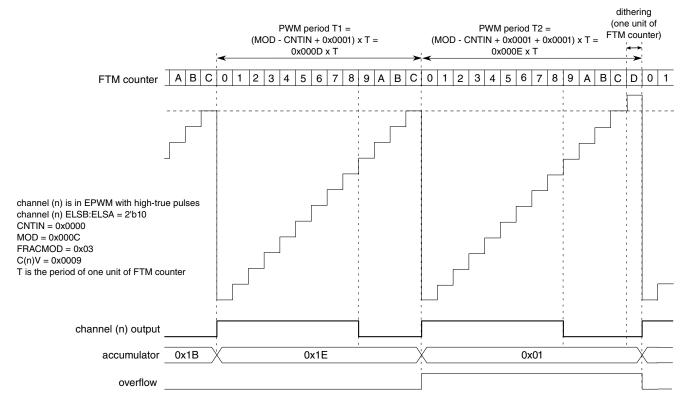


Figure 39-104. PWM Period Dithering with Up Counting

Assuming:

- the FTM counter is an up counter,
- T is one unit of FTM counter,
- the PWM period without period dithering is [(MOD CNTIN + 1) x T],
- the number of PWM periods with period dithering is FRACMOD,
- the PWM period with period dithering is $[(MOD CNTIN + 1 + 1) \times T]$,

thus, the average period (in decimal) is $[(MOD - CNTIN + 1) + (FRACMOD/32)] \times T$, where the integer value is (MOD - CNTIN + 1) and the fractional value is (FRACMOD/ 32). See the example below.

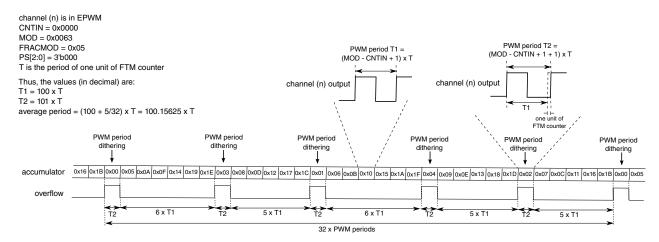


Figure 39-105. Example of Average Period when the PWM Period Dithering is used with the Up Counting

NOTE

For the generation of 100% PWM signal in the channel (n) (with channel (n) ELSB:ELSA = 2'b10) using EPWM mode and PWM Period Dithering, it is recommended to use (C(n) > MOD + 1).

For the generation of PWM signals in the channel (n) (with channel (n) ELSB:ELSA = 2'b10) using Combine mode and PWM Period Dithering, it is recommended to use:

- For 0% PWM signal: (C(n)V > MOD + 1) and (C(n+1)V > MOD + 1);
- For 100% PWM signal: (C(n)V = CNTIN) and (C(n+1)V > MOD + 1).

39.5.33.1.2 Up-Down Counting

When the FTM counter is an up-down counter and the PWM period dithering is enabled, at the end of each PWM period, the FRACMOD value is added to an internal 5-bit accumulator. When this accumulator overflows (that is, the result of the adding is greater or equal than 0x20), then one unit of FTM counter is added to the end of the current PWM period and other unit is added to the begin of the next PWM period (see the figure below). After the accumulator overflows, the accumulator remains with the rest of the subtraction: (the result of this adding - 0x20).

Due to one unit of FTM counter that can be added to the PWM period, the largest valid value for MOD is 0x7FFE for PWM period dithering in up-down counting (CPWM mode).

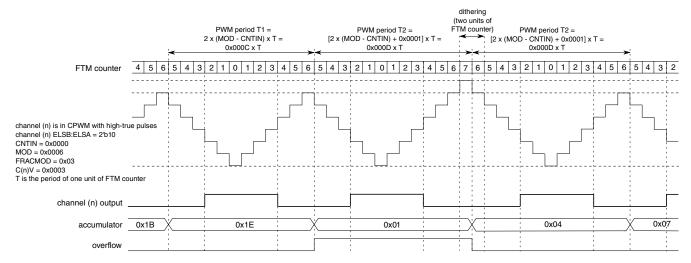


Figure 39-106. PWM Period Dithering with Up-Down Counting

NOTE

For the generation of 100% PWM signal in the channel (n) (with channel (n) ELSB:ELSA = 2'b10) using CPWM mode and PWM Period Dithering, it is recommended to use (C(n)V[15] = 0) and (C(n)V > MOD + 1) and $(MOD \neq$ 0x0000).

39.5.33.2 **PWM Edge Dithering**

The channel (n) internal accumulator used in the PWM edge dithering is reset when:

- the field VAL of the register C(n)V_MIRROR is updated with the value of its write buffer.
- the FRACVAL is updated with the value of its write buffer, or
- the FTM counter is stopped.

NOTE

For the PWM edge dithering, the register C(n)V_MIRROR should be used instead of the register C(n)V.

To avoid inconsistencies, the field FRACVAL is cleared when the field VAL of the register C(n)V is updated with the value of its write buffer.

The PWM edge dithering is not available:

- to the channel in input modes, and
- to the channel in output compare mode.

39.5.33.2.1 EPWM Mode

The PWM edge dithering for channel (n) in EPWM mode is enabled when a non-zero value is written to the channel (n) FRACVAL.

If the channel (n) is in EPWM mode and the PWM edge dithering is enabled, at the end of each EPWM period, the channel (n) FRACVAL value is added to the channel (n) internal 5-bit accumulator. When this accumulator overflows (that is, the result of the adding is greater or equal than 0x20), the accumulator remains with the rest of the subtraction: (the result of this adding - 0x20).

In this configuration, the initial edge of EPWM duty cycle happens when (FTM counter = CNTIN), its position is not modified by the PWM edge dithering. If there was not the overflow of the channel (n) accumulator in the current EPWM period, then the final edge of EPWM duty cycle happens on the channel (n) match (FTM counter = C(n)V), that is, its position is not modified by the edge dithering. However, if there was the overflow of the channel (n) accumulator in the current EPWM period, then the final edge of EPWM duty cycle happens when (FTM counter = C(n)V + 0x0001).

The figure below shows an example of PWM edge dithering when the channel (n) is in EPWM mode.

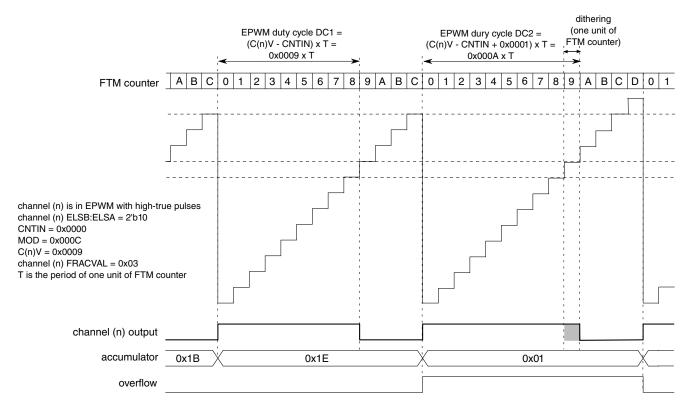


Figure 39-107. Channel (n) is in EPWM Mode with PWM Edge Dithering

Assuming:

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

- the channel (n) is in EPWM mode,
- T is one unit of FTM counter,
- the EPWM duty cycle without edge dithering is [(C(n)V CNTIN) x T],
- the number of PWM periods which duty cycle that has edge dithering is FRACVAL,
- the EWM duty cycle with edge dithering is $[(C(n)V CNTIN + 1) \times T]$,

thus, the average duty cycle (in decimal) is $[(C(n)V - CNTIN) + (FRACVAL/32)] \times T$, where the integer value is (C(n)V - CNTIN) and the fractional value is (FRACVAL/32). See the example below.

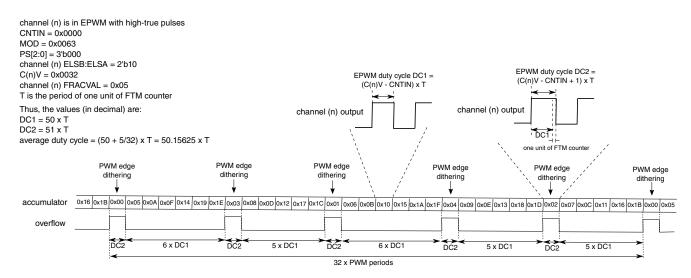


Figure 39-108. Example of Average Duty Cyle when the Channel (n) is in EPWM Mode with PWM Edge Dithering

39.5.33.2.2 CPWM Mode

The PWM edge dithering for channel (n) in CPWM mode is enabled when a non-zero value is written to the channel (n) FRACVAL.

If the channel (n) is in CPWM mode and the PWM edge dithering is enabled, at the end of each CPWM period, the channel (n) FRACVAL value is added to the channel (n) internal 5-bit accumulator. When this accumulator overflows (that is, the result of the adding is greater or equal than 0x20), the accumulator remains with the rest of the subtraction: (the result of this adding - 0x20).

In this configuration, if there was not the overflow of the channel (n) accumulator in the current CPWM period, then the duty cycle is not modified by the PWM edge dithering, that is, the initial edge of CPWM duty cycle happens on channel (n) match (FTM counter = C(n)V) when the FTM counter is decrementing, and the final edge of CPWM duty cycle on channel (n) match when the FTM counter is incrementing.

NXP Semiconductors

However, if there was the overflow of the channel (n) accumulator in the current CPWM period, then the initial edge of CPWM duty cycle happens when (FTM counter = C(n)V + 0x0001) and the FTM counter is decrementing, and the final edge of CPWM duty cycle when (FTM counter = C(n)V + 0x0001) and the FTM counter is incrementing.

The figure below shows an example of PWM edge dithering when the channel (n) is in CPWM mode.

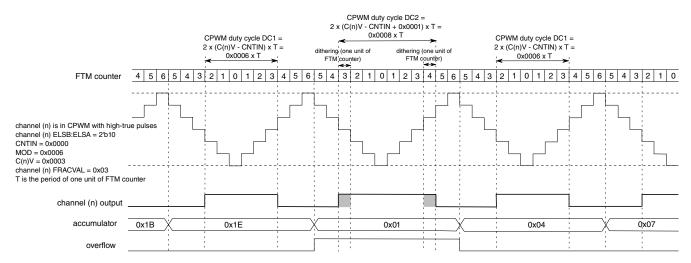


Figure 39-109. Channel (n) is in CPWM Mode with PWM Edge Dithering

39.5.33.2.3 Combine Mode

In the Combine mode, the PWM edge dithering can be done:

- in the channel (n) match (FTM counter = C(n)V) edge or
- in the channel (n+1) match (FTM counter = C(n+1)V edge.

The channel (n) match edge dithering is enabled when a non-zero value is written to the channel (n) FRACVAL.

For the channel (n) match edge dithering, the channel (n) has an internal 5-bit accumulator. At the end of each PWM period, the channel (n) FRACVAL value is added to the channel (n) accumulator. When this accumulator overflows (that is, the result of the adding is greater or equal than 0x20), the accumulator remains with the rest of the subtraction: (the result of this adding - 0x20).

If there was not the overflow of the channel (n) accumulator in the current PWM period, the channel (n) match edge is not modified, that is, it happens on channel (n) match. However, if there was the overflow of the channel (n) accumulator, the channel (n) match edge happens when (FTM counter = C(n)V + 0x0001).

The figure below shows an example of the channel (n) match edge dithering when the channels (n) and (n+1) are in Combine mode.

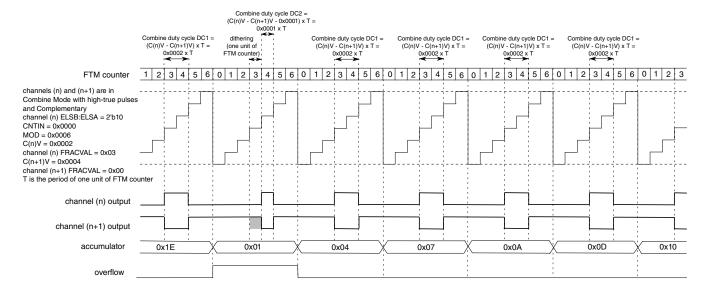


Figure 39-110. Channel (n) Match Edge Dithering in Combine Mode

The channel (n+1) match edge dithering is enabled when a non-zero value is written to the channel (n+1) FRACVAL.

For the channel (n+1) match edge dithering, the channel (n+1) has an internal 5-bit accumulator. At the end of each PWM period, the channel (n+1) FRACVAL value is added to the channel (n+1) accumulator. When this accumulator overflows (that is, the result of the adding is greater or equal than 0x20), the accumulator remains with the rest of the subtraction: (the result of this adding - 0x20).

If there was not the overflow of the channel (n+1) accumulator in the current PWM period, the channel (n+1) match edge is not modified, that is, it happens on channel (n+1) match. However, if there was the overflow of the channel (n+1) accumulator, the channel (n+1) match edge happens when (FTM counter = C(n+1)V + 0x0001).

The figure below shows an example of the channel (n+1) match edge dithering when the channels (n) and (n+1) are in Combine mode.

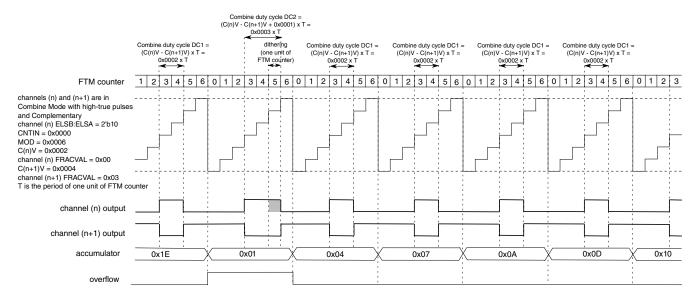


Figure 39-111. Channel (n+1) Match Edge Dithering in Combine Mode

NOTE

It is recommended to use only one PWM Edge Dithering (channel (n) PWM Edge Dithering or channel (n+1) PWM Edge Dithering) at a time.

For the generation of 0% PWM in the channel (n) (with channel (n) ELSB:ELSA = 2'b10) using Combine mode and PWM Edge Dithering, it is recommended to use:

- (C(n)V < CNTIN or C(n)V > MOD) and (channel (n) FRACVAL is zero) and
- (channel (n+1) FRACVAL is zero).

For the generation of 100% PWM in the channel (n) (with channel (n) ELSB:ELSA = 2'b10) using Combine mode and PWM Edge Dithering, it is recommended to use:

- (C(n)V = CNTIN) and (channel (n) FRACVAL is zero) and
- (C(n+1)V < CNTIN or C(n+1)V > MOD) and (channel (n +1) FRACVAL is zero).

39.6 Reset overview

The FTM is reset whenever any chip reset occurs.

When the FTM exits from reset:

Reset overview

- the FTM counter and the prescaler counter are zero and are stopped (CLKS[1:0] = 00b);
- the timer overflow interrupt is zero, see Timer Overflow Interrupt;
- the channels interrupts are zero, see Channel (n) Interrupt;
- the fault interrupt is zero, see Fault Interrupt;
- the channels are in input capture mode, see Input Capture mode;
- the channels outputs are zero;
- the channels pins are not controlled by FTM (channel (n) ELSB:ELSA = 0:0) (Channel Modes).

The following figure shows the FTM behavior after the reset. At the reset (item 1), the FTM counter is disabled (see the CLKS its in the register SC), its value is updated to zero and the pins are not controlled by FTM (Channel Modes).

After the reset, the FTM should be configurated (item 2). It is necessary to define the FTM counter mode, the FTM counting limits (MOD and CNTIN registers value), the channels mode and CnV registers value according to the channels mode.

Thus, it is recommended to write any value to CNT register (item 3). This write updates the FTM counter with the CNTIN register value and the channels output with its initial value (except for channels in output compare mode) (Counter reset).

The next step is to select the FTM counter clock by the CLKS[1:0] bits (item 4). It is important to highlight that the pins are only controlled by FTM when CLKS[1:0] bits are different from zero (Channel Modes).

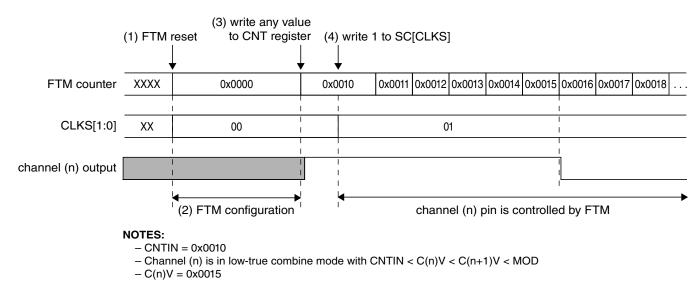


Figure 39-112. FTM behavior after reset when the channel (n) is in Combine mode

The following figure shows an example when the channel (n) is in Output Compare mode and the channel (n) output is toggled when there is a match. In the Output Compare mode, the channel output is not updated to its initial value when there is a write to CNT

register (item 3). In this case, use the software output control (Software Output Control Mode) or the initialization (Initialization) to update the channel output to the selected value (item 4).

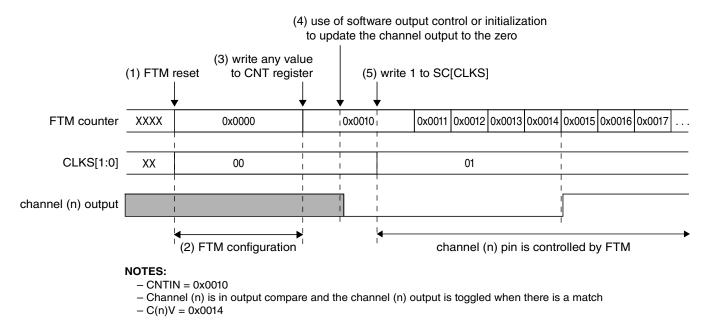


Figure 39-113. FTM behavior after reset when the channel (n) is in Output Compare mode

39.7 FTM Interrupts

39.7.1 Timer Overflow Interrupt

The timer overflow interrupt is generated when (TOIE = 1) and (TOF = 1).

39.7.2 Reload Point Interrupt

The Reload Point interrupt is generated when (RIE = 1) and (RF = 1).

39.7.3 Channel (n) Interrupt

The channel (n) interrupt is generated when (CHIE = 1) and (CHF = 1).

39.7.4 Fault Interrupt

The fault interrupt is generated when (FAULTIE = 1) and (FAULTF = 1).

39.8 Initialization Procedure

The following initialization procedure is recommended to configure the FlexTimer operation. This procedure can also be used to do a new configuration of the FlexTimer operation.

- 1. Define the POL bits.
- 2. Mask the channels outputs using SYNCHOM = 0. Two clocks after the write to OUTMASK, the channels output are in the safe value.
- 3. (Re)Configuration FTM counter and channels to generation of periodic signals:
 - Disable the clock. If the selected mode is Quadrature Decoder, then disable this mode.
 - Write to MOD.
 - Write to CNTIN.
 - Configure the channels that will be used.
 - Select the high-true and low-true channels modes.
 - Write to CnV for all channels that will be used .
 - (Re)Configure deadtime and fault control.
 - Do not use the SWOC without SW synchronization (see item 6).
 - Do not use the Inverting without SW synchronization (see item 6).
 - Do not use the Initialization.
 - Do not change the polarity control.
 - Do not configure the HW synchronization
- 4. Write any value to CNT. The FTM Counter is reset and the channels output are updated according to new configuration.
- 5. Enable the clock. Write to CLKS[1:0] bits a value different from zero. If in the Quadrature Decoder mode, enable this mode.
- 6. Configure the SW synchronization for SWOC (if it is necessary), Inverting (if it is necessary) and Output Mask (always)
 - Select synchronization for Output Mask Write to SYNC (SWSYNC = 0, TRIG2 = 0, TRIG1 = 0, TRIG0 = 0, SYNCHOM = 1, REINIT = 0, CNTMAX = 0, CNTMIN = 0)
 - Write to SYNCONF.
 - HW Synchronization can not be enabled (HWSOC = 0, HWINVC = 0, HWOM = 0, HWWRBUF = 0, HWRSTCNT = 0, HWTRIGMODE = 0).
 - SW Synchronization for SWOC (if it is necessary): SWSOC = [0/1] and SWOC = [0/1].

1005

- SW Synchronization for Inverting (if it is necessary): SWINVC = [0/1] and INVC = [0/1].
- SW Synchronization for SWOM (always): SWOM = 1. No enable the SW Synchronization for write buffers (because the writes to registers with write buffer are done using CLKS[1:0] = 2'b00): SWWRBUF = 0 and CNTINC = 0.
- SW Synchronization for counter reset (always): SWRSTCNT = 1.
- Enhanced synchronization (always): SYNCMODE = 1.
- If the SWOC is used (SWSOC = 1 and SWOC = 1), then write to SWOCTRL register.
- If the Inverting is used (SWINVC = 1 and INVC = 1), then write to INVCTRL register.
- Write to OUTMASK to enable the masked channels.
- 7. Generate the Software Trigger Write to SYNC (SWSYNC = 1, TRIG2 = 0, TRIG1 = 0, TRIG0 = 0, SYNCHOM = 1, REINIT = 0, CNTMAX = 0, CNTMIN = 0)
- 8. Write to PWM_EN to enable the PWM outputs.

39.9 Usage Guide

39.9.1 FTM Interrupts

The FlexTimer has multiple sources of interrupt. However, these sources are OR'd together to generate a single interrupt request to the interrupt controller. When an FTM interrupt occurs, read the FTM status registers (FMS, SC, and STATUS) to determine the exact interrupt source.

39.9.2 FTM Hall sensor support

For 3 phase motor control sensor-ed applications the use of Hall sensors, generally 3 sensors placed 120 degrees apart around the rotor, are deployed to detect position and speed. Each of the 3 sensors provides a pulse that applied to an input capture pin, can then be analyzed and both speed and position can be deduced. This device has two 2-channel FTMs. (FTM1 and FTM2) and thus provides 4 input capture pins. To simplify the calculations required by the CPU on each hall sensor's input, if all 3 inputs are "exclusively OR'd" into one timer channel and the free running counter is refreshed on every edge then this can simplify the speed calculation.

Usage Guide

Via the SIM module and SIM_FTMOPT1 register the FTM2CH1SEL bit provides the choice of normal FTM2_CH1 input or the XOR of FTM2_CH0, FTM2_CH1 and FTM1_CH1 pins that will be applied to FTM2_CH1.

NOTE

If the user utilizes FTM1_CH1 to be an input to FTM2_CH1, FTM1_CH0 can still be utilized for other functions.

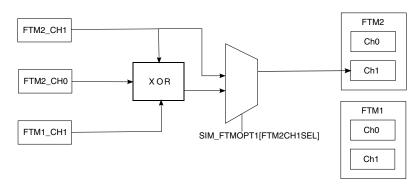


Figure 39-114. FTM Hall Sensor Configuration

39.9.3 FTM Modulation Implementation

FTM0 support a modulation function where the output channels when configured as PWM or Output Compare mode modulate another timer output when the channel signal is asserted. Any of the 8 channels of FTM0 can be configured to support this modulation function.

The SIM_FTMOPT1 register has control bits (FTMxCHySEL) that allow the user to select normal PWM/Output Compare mode on the corresponding FTM timer channel or modulate with FTM1_CH1. The diagram below shows the implementation for FTM0. See SIM Block Guide for further information.

When FTM1_CH1 is used to modulate an FTM0 channel, then the user must configure FTM1_CH1 to provide a signal that has a higher frequency than the modulated FTM0 channel output. Also it limits the use of the FTM1_CH0 function, as the FTM1_CH1 will be programmed to provide a 50% duty PWM signal and limit the start and modulus values for the free running counter.

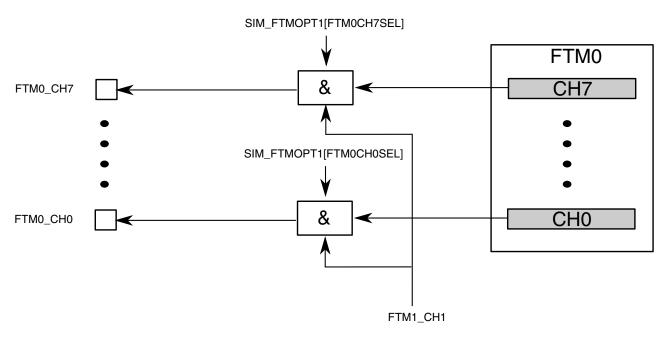
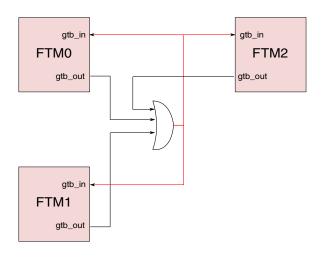


Figure 39-115. FTM Output Modulation

39.9.4 FTM Global Time Base

This chip provides the optional FTM global time base feature, see Global time base (GTB).

FTM supports global timer base through the GTB feature. Any of the FTM module could be used as the GTB_EN source. The global timer base only allows the FTM counters to start their operation synchronously, it does not automatically provide continuous synchronization of FTM counters, meaning that the FTM counters may lose synchronization during misc FTM operation.



Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Usage Guide

FTM BDM and debug halt mode 39.9.5

In the FTM chapter, references to the chip being in "BDM" are the same as the chip being in "debug halt mode".

Chapter 40 Low-power Periodic Interrupt Timer (LPIT)

40.1 Chip-specific Information for this Module

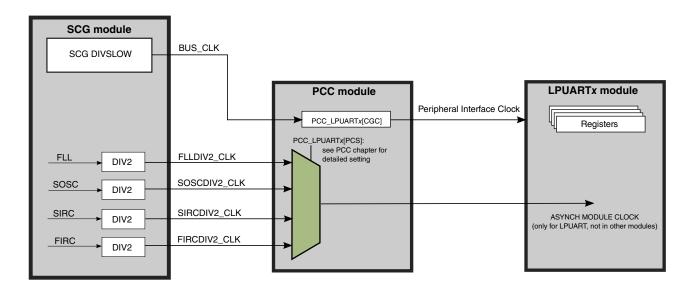
40.1.1 Instantiation Information

This device contains one LPIT module with four channels.

40.1.2 LPIT Clocking Information

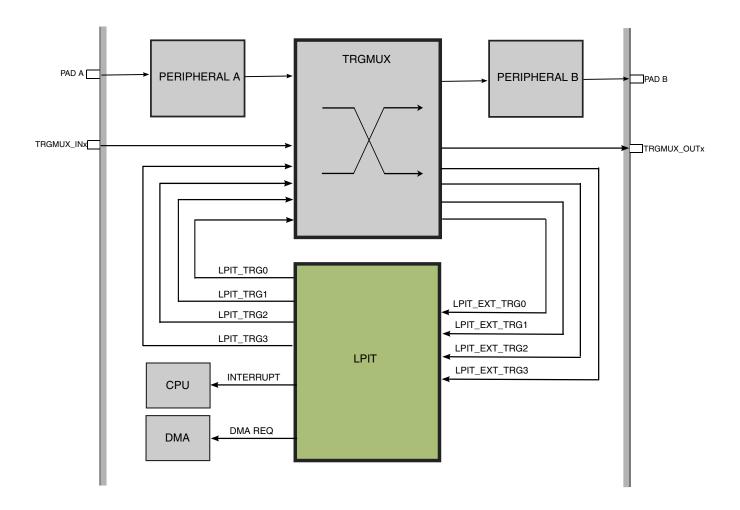
The LPIT module is only clocked by system clock shown in following diagram.

Peripheral Clocking - LPUART Note: this example figure also applies similarly to the clocking for LPSPI, LPI2C, and LPIT.



Inter-connectivity Information

The LPIT module interconnectivity with other peripherals is based on the TRGMUX.



40.2 Introduction

40.2.1 **Overview**

The Low Power Periodic Interrupt Timer (LPIT) is a multi-channel timer module generating independent pre-trigger and trigger outputs. These timer channels can operate individually or can be chained together. The LPIT can operate in low power modes if configured to do so. The pre-trigger and trigger outputs can be used to trigger other modules on the device.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Each timer channel can be configured to run independently and made to work in either compare or capture modes. In compare mode, the timers decrement when enabled and generate an output pre-trigger and timeout pulse. The trigger output is 1 clock cycle delayed of the pre-trigger pulse. Each timer channel start, reload and restart can be controlled via control bits. The timer can be configured to always decrement, or decrement on selected trigger inputs or previous channel timeout (when channels are chained). By chaining timer channels, applications can achieve larger timeout durations. In capture mode, the timer can be used to perform measurements as the timer value is captured (in the timer value register) when a selected trigger input is asserted. In capture mode, the timer can support once-off or multiple measurements (for example, frequency measurements).

The timer channels operate on an asynchronous clock, which is independent from the register read/write access clock. Clock synchronization between the clock domains ensures normal operations.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

40.2.2 Block Diagram

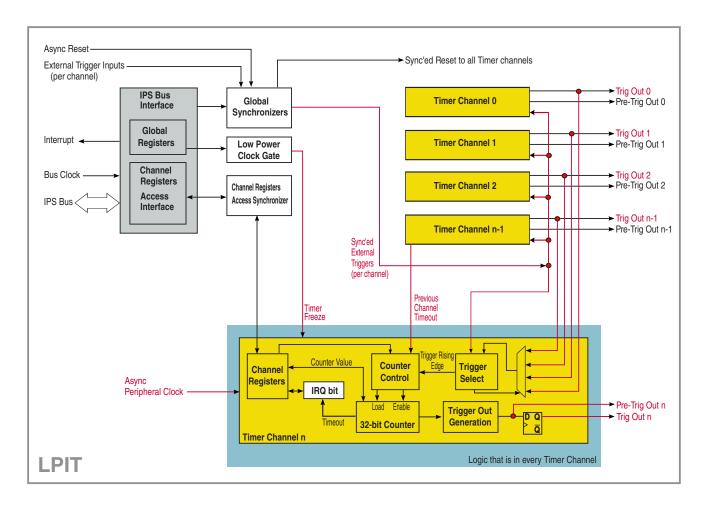


Figure 40-1. Top Level Block Diagram

40.3 Modes of operation

The LPIT module supports the chip modes described in the following table.

Table 40-1. Chip modes supported by the LPIT module

Chip mode	LPIT Operation
Run	Normal operation
Stop/Wait	Can continue operating provided the Doze Enable bit (MCR[DOZE_EN]) is set and the LPIT is using an external or internal clock source which remains operating during stop/wait modes.
Debug	Can continue operating provided the Debug Enable bit (MCR[DBG_EN]) is set.

40.4 Memory Map and Registers

The memory map comprises of 32-bit aligned registers which can be accessed via 8-bit, 16-bit, or 32-bit accesses. Write access to reserved locations will generate a transfer error. Read access to reserved locations will also generate a transfer error and the read data bus will show all 0s. The Memory Map and complete module is in Big Endian format.

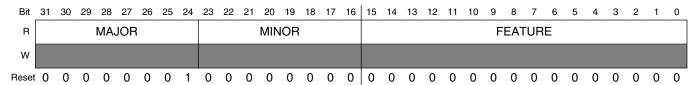
The module will not check for correctness of programmed values in the registers and software must ensure that correct values are being written.

LPIT memory map

Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page
4003_7000	Version ID Register (LPIT0_VERID)	32	R	0100_0000h	40.4.1/1014
4003_7004	Parameter Register (LPIT0_PARAM)	32	R	0000_0404h	40.4.2/1014
4003_7008	Module Control Register (LPIT0_MCR)	32	R/W	0000_0000h	40.4.3/1015
4003_700C	Module Status Register (LPIT0_MSR)	32	w1c	0000_0000h	40.4.4/1016
4003_7010	Module Interrupt Enable Register (LPIT0_MIER)	32	R/W	0000_0000h	40.4.5/1017
4003_7014	Set Timer Enable Register (LPIT0_SETTEN)	32	R/W	0000_0000h	40.4.6/1018
4003_7018	Clear Timer Enable Register (LPIT0_CLRTEN)	32	W (always reads 0)	0000_0000h	40.4.7/1019
4003_7020	Timer Value Register (LPIT0_TVAL0)	32	R/W	0000_0000h	40.4.8/1020
4003_7024	Current Timer Value (LPIT0_CVAL0)	32	R	FFFF_FFFFh	40.4.9/1021
4003_7028	Timer Control Register (LPIT0_TCTRL0)	32	R/W	0000_0000h	40.4.10/ 1022
4003_7030	Timer Value Register (LPIT0_TVAL1)	32	R/W	0000_0000h	40.4.8/1020
4003_7034	Current Timer Value (LPIT0_CVAL1)	32	R	FFFF_FFFFh	40.4.9/1021
4003_7038	Timer Control Register (LPIT0_TCTRL1)	32	R/W	0000_0000h	40.4.10/ 1022
4003_7040	Timer Value Register (LPIT0_TVAL2)	32	R/W	0000_0000h	40.4.8/1020
4003_7044	Current Timer Value (LPIT0_CVAL2)	32	R	FFFF_FFFFh	40.4.9/1021
4003_7048	Timer Control Register (LPIT0_TCTRL2)	32	R/W	0000_0000h	40.4.10/ 1022
4003_7050	Timer Value Register (LPIT0_TVAL3)	32	R/W	0000_0000h	40.4.8/1020
4003_7054	Current Timer Value (LPIT0_CVAL3)	32	R	FFFF_FFFFh	40.4.9/1021
4003_7058	Timer Control Register (LPIT0_TCTRL3)	32	R/W	0000_0000h	40.4.10/ 1022

40.4.1 Version ID Register (LPITx_VERID)

Address: 4003_7000h base + 0h offset = 4003_7000h



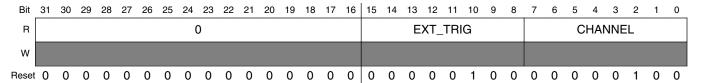
LPITx_VERID field descriptions

Field	Description
31–24 MAJOR	Major Version Number
WIAJOR	This read only field returns the major version number for the module specification
23–16 MINOR	Minor Version Number
	This read only field returns the minor version number for the module specification
FEATURE	Feature Number
	This read only field returns the feature set number.

40.4.2 Parameter Register (LPITx_PARAM)

This register provides details on the parameter settings that were used while including this module in the device.

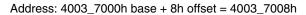
Address: 4003_7000h base + 4h offset = 4003_7004h

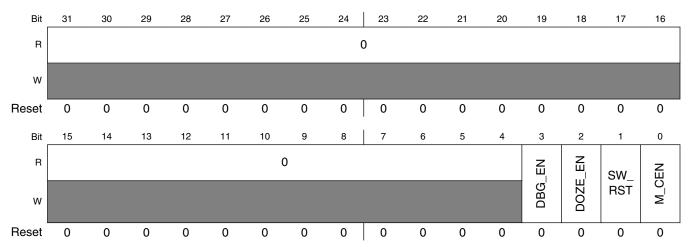


LPITx_PARAM field descriptions

Field	Description
31–16 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
15–8 EXT_TRIG	Number of External Trigger Inputs
	Number of external triggers implemented.
CHANNEL	Number of Timer Channels
	Number of timer channels implemented.

40.4.3 Module Control Register (LPITx_MCR)





LPITx_MCR field descriptions

Field	Description
31–4 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
3 DBG_EN	Debug Enable Bit Allows the timer channels to be stopped when the device enters the Debug mode
	O Timer channels are stopped in Debug mode Timer channels continue to run in Debug mode
2 DOZE_EN	DOZE Mode Enable Bit Allows the timer channels to be stopped or continue to run when the device enters the DOZE mode
	Timer channels are stopped in DOZE mode Timer channels continue to run in DOZE mode
1 SW_RST	Software Reset Bit Resets all channels and registers, except the Module Control Register. Remains set until cleared by software.
	 Timer channels and registers are not reset Timer channels and registers are reset
0 M_CEN	Module Clock Enable Enables the peripheral clock to the module timers. M_CEN bit must be asserted when writing to timer registers. Both clocks (bus clock and peripheral clock) must be enabled, to allow for clock synchronization and update of register bits. NOTE: Writing to the MSR, SETTEN, CLRTEN, TCTRL, and TVAL registers while M_CEN = 0, will lead to the assertion of a transfer error for that bus cycle. Writing to CVAL and reserved registers will always generate a transfer error.

Table continues on the next page...

NXP Semiconductors

1015

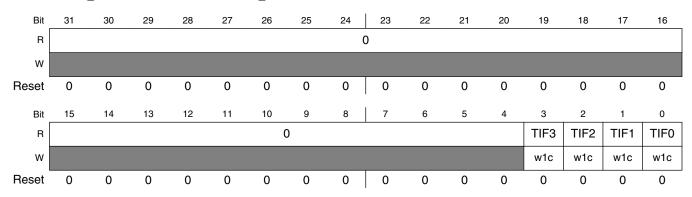
Memory Map and Registers

LPITx_MCR field descriptions (continued)

Field	Description
	0 Protocol clock to timers is disabled
	1 Protocol clock to timers is enabled

40.4.4 Module Status Register (LPITx_MSR)

Address: 4003_7000h base + Ch offset = 4003_700Ch



LPITx_MSR field descriptions

Field	Description
31–4	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
3 TIF3	Channel 3 Timer Interrupt Flag
	In compare modes, sets to 1 at the end of the timer period. In capture modes, sets to 1 when the trigger asserts. Writing logic 1 to this flag clears it. Writing 0 has no effect.
	0 Timer has not timed out
	1 Timeout has occurred
2 TIF2	Channel 2 Timer Interrupt Flag
	In compare modes, sets to 1 at the end of the timer period. In capture modes, sets to 1 when the trigger asserts. Writing logic 1 to this flag clears it. Writing 0 has no effect.
	0 Timer has not timed out
	1 Timeout has occurred
1 TIF1	Channel 1 Timer Interrupt Flag
	In compare modes, sets to 1 at the end of the timer period. In capture modes, sets to 1 when the trigger asserts. Writing logic 1 to this flag clears it. Writing 0 has no effect.
	0 Timer has not timed out
	1 Timeout has occurred
0 TIF0	Channel 0 Timer Interrupt Flag
	In compare modes, sets to 1 at the end of the timer period. In capture modes, sets to 1 when the trigger asserts. Writing logic 1 to this flag clears it. Writing 0 has no effect.

Table continues on the next page...

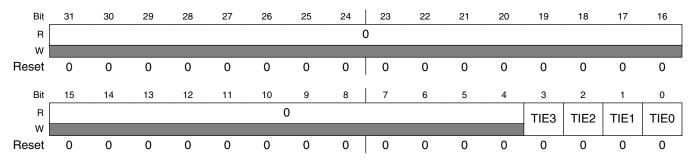
Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

LPITx_MSR field descriptions (continued)

Field	Description
	0 Timer has not timed out
	1 Timeout has occurred

40.4.5 Module Interrupt Enable Register (LPITx_MIER)

Address: 4003_7000h base + 10h offset = 4003_7010h

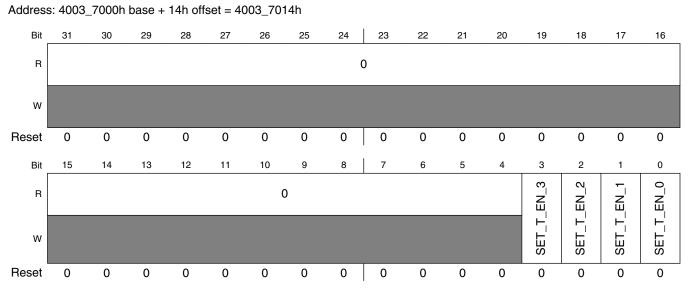


LPITx_MIER field descriptions

Field	Description
31–4 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
3 TIE3	Channel 3 Timer Interrupt Enable Enables interrupt generation when this bit is set to 1 and if corresponding Timer Interrupt Flag is asserted.
	0 Interrupt generation is disabled1 Interrupt generation is enabled
2 TIE2	Channel 2 Timer Interrupt Enable Enables interrupt generation when this bit is set to 1 and if corresponding Timer Interrupt Flag is asserted.
	0 Interrupt generation is disabled1 Interrupt generation is enabled
1 TIE1	Channel 1 Timer Interrupt Enable Enables interrupt generation when this bit is set to 1 and if corresponding Timer Interrupt Flag is asserted.
	0 Interrupt generation is disabled1 Interrupt generation is enabled
0 TIE0	Channel 0 Timer Interrupt Enable
	Enables interrupt generation when this bit is set to 1 and if corresponding Timer Interrupt Flag is asserted. Unterrupt generation is disabled Interrupt generation is enabled

40.4.6 Set Timer Enable Register (LPITx_SETTEN)

This register allows simulataneous enabling of timer channels. Timer channels can be enabled either by writing '1' to T_EN in respective TCTRLn register or setting the corresponding bit in this register. Writing a '0' to this register has no effect. CLRTEN register should be used to disable timer channels simultaneously.



LPITx_SETTEN field descriptions

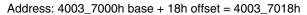
Field	Description
31–4 Decembed	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
3	Set Timer 3 Enable
SET_T_EN_3	MANUEL 141. 112. 112. 113. 114. 115. 115. 115. 115. 115. 115. 115
	Writing '1' to this bit will enable the timer channel 3. This bit can be used in addition to T_EN bit in TCTRL3 register. Writing a 0 will not disable the counter. This bit will be cleared when T_EN bit in TCTRL3 is set to '0' or '1' is written to the CLR_T_EN_3 bit in CLRTEN register.
	0 No effect
	1 Enables the Timer Channel 3
2	Set Timer 2 Enable
SET_T_EN_2	
	Writing '1' to this bit will enable the timer channel 2. This bit can be used in addition to T_EN bit in TCTRL2 register. Writing a 0 will not disable the counter. This bit will be cleared when T_EN bit in TCTRL2 is set to '0' or '1' is written to the CLR_T_EN_2 bit in CLRTEN register.
	0 No Effect
	1 Enables the Timer Channel 2
1	Set Timer 1 Enable
SET_T_EN_1	

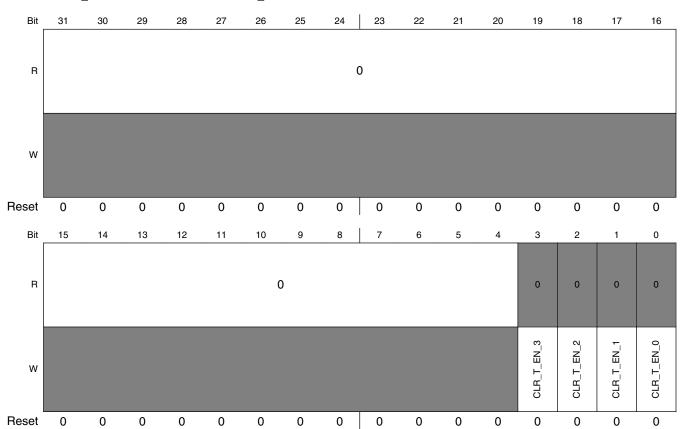
Table continues on the next page...

LPITx_SETTEN field descriptions (continued)

Field	Description
	Writing '1' to this bit will enable the timer channel 1. This bit can be used in addition to T_EN bit in TCTRL1 register. Writing a 0 will not disable the counter. This bit will be cleared when T_EN bit in TCTRL1 is set to '0' or '1' is written to the CLR_T_EN_1 bit in CLRTEN register.
	0 No Effect 1 Enables the Timer Channel 1
0 SET_T_EN_0	Set Timer 0 Enable Writing '1' to this bit will enable the timer channel 0. This bit can be used in addition to T_EN bit in TCTRL0 register. Writing a 0 will not disable the counter. This bit will be cleared when T_EN bit in TCTRL0 is set to 0 or '1' is written to the CLR_T_EN_0 bit in CLRTEN register.
	0 No effect 1 Enables the Timer Channel 0

40.4.7 Clear Timer Enable Register (LPITx_CLRTEN)





Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

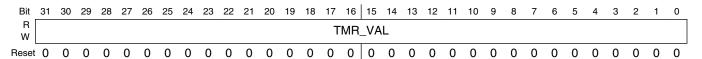
LPITx_CLRTEN field descriptions

Field	Description
31–4	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
3 CLR_T_EN_3	Clear Timer 3 Enable
	Writing a '1' to this bit will disable the timer channel 3. This bit can be used in addition to T_EN bit in
	TCTRL3 register. Writing a 1 will not enable the counter. This bit is self clearing and will always read 0.
	0 No Action
	1 Clear T_EN bit for Timer Channel 3
2 CLR_T_EN_2	Clear Timer 2 Enable
OLII_I_LII_Z	Writing a '1' to this bit will disable the timer channel 2. This bit can be used in addition to T_EN bit in
	TCTRL2 register. Writing a 1 will not enable the counter. This bit is self clearing and will always read 0.
	0 No Action
	1 Clear T_EN bit for Timer Channel 2
1	Clear Timer 1 Enable
CLR_T_EN_1	Writing a '1' to this bit will disable the timer channel 1. This bit can be used in addition to T_EN bit in
	TCTRL1 register. Writing a 1 will not enable the counter. This bit is self clearing and will always read 0.
	0 No Action
	1 Clear T_EN bit for Timer Channel 1
0	Clear Timer 0 Enable
CLR_T_EN_0	Writing a '1' to this bit will disable the timer channel 0. This bit can be used in addition to T_EN bit in
	TCTRL0 register. Writing a 1 will not enable the counter. This bit is self clearing and will always read 0.
	0 No action
	1 Clear T_EN bit for Timer Channel 0

40.4.8 Timer Value Register (LPITx_TVALn)

In compare modes, these registers select the timeout period for the timer channels. In capture modes, these registers are loaded with the value of the counter when the trigger asserts.

Address: 4003_{7000h} base + 20h offset + $(16d \times i)$, where i=0d to 3d



LPITx_TVALn field descriptions

Field	Description	
TMR_VAL	Timer Value	

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

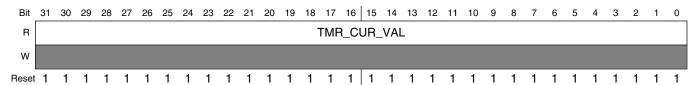
LPITx_TVALn field descriptions (continued)

Field	Description
In compare modes, sets the timer channel start value. The timer will count down until it re will generate an interrupt and load this register value again. Writing a new value to this re restart the timer channel; instead the value will be loaded after the timer expires. To abore and start a timer period with the new value, the timer channel must be disabled and enabled.	
	In capture modes, this register stores the inverse of the counter whenever the trigger asserts.
	0 Invalid load value in compare modes
	>0 Value to be loaded (Compare Mode) or Value of Timer (Capture Mode)

40.4.9 Current Timer Value (LPITx_CVALn)

These registers indicate the current timer counter value.

Address: 4003_{7000h} base + 24h offset + (16d × i), where i=0d to 3d



LPITx_CVALn field descriptions

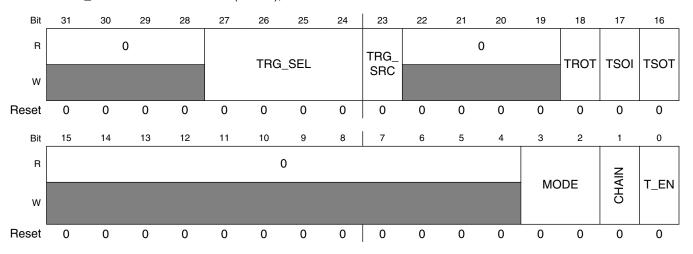
Field	Description
TMR_CUR_VAL	Current Timer Value
	Represents the current timer value, if the timer is enabled.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

40.4.10 Timer Control Register (LPITx_TCTRLn)

These registers contain the control bits for each timer channel

Address: 4003_{7000h} base + 28h offset + (16d × i), where i=0d to 3d



LPITx_TCTRLn field descriptions

Field	Description
31–28 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
27–24 TRG_SEL	Trigger Select
	Selects the trigger to use for starting and/or reloading the LPIT timer. This field should only be changed when the LPIT timer channel is disabled. The TRG_SRC bit selects between internal and external trigger signals for each channel.
	The TRG_SEL bits select one trigger from the set of internal or external triggers selected by TRG_SRC.
	0 Timer channel 0 trigger source is selected
	1 Timer channel 1 trigger source is selected
	2 Timer channel 2 trigger source is selected
	n Timer channel 'n' trigger source is selected
23	Trigger Source
TRG_SRC	Selects between internal or external trigger sources. The final trigger is selected by TRG_SEL depending on which trigger source out of internal triggers or external triggers are selected by TRG_SRC.
	Refer to the chip configuration section for available external trigger options. If a channel does not have an associated external trigger then this bit for that channel should be set to 1.
	0 Trigger source selected in external
	1 Trigger source selected is the internal trigger
22–19	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
18	Timer Reload On Trigger
TROT	

Table continues on the next page...

LPITx_TCTRLn field descriptions (continued)

Field	Description
	When set, the LPIT timer will reload when a rising edge is detected on the selected trigger input. The trigger input is ignored if the LPIT is disabled during debug mode or DOZE mode (DOZE_EN or DBGEN = 0)
	0 Timer will not reload on selected trigger
	1 Timer will reload on selected trigger
17 TSOI	Timer Stop On Interrupt
	This bit controls whether the channel timer will stop after it times out and when it can restart (when TSOT = 0). If TSOT = 1, then the timer will stop on timeout and will restart after a rising edge on the selected trigger is detected. If TSOT = 0, then this bit controls when the timer restarts.
	0 Timer does not stop after timeout
	1 Timer will stop after timeout and will restart after rising edge on the T_EN bit is detected (i.e. timer channel is disabled and then enabled)
16 TSOT	Timer Start On Trigger
	This bit controls when the timer starts decrementing.
	Timer starts to decrement immediately based on restart condition (controlled by TSOI bit)
	1 Timer starts to decrement when rising edge on selected trigger is detected
15–4	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
3–2 MODE	Timer Operation Mode
MODE	Configures the Channel Timer Mode of Operation. The mode bits control how the timer decrements. See Functional Description for more details.
	00 32-bit Periodic Counter
	01 Dual 16-bit Periodic Counter
	10 32-bit Trigger Accumulator
	11 32-bit Trigger Input Capture
1 CHAIN	Chain Channel
CHAIN	When enabled, timer channel will decrement when channel N-1 trigger asserts. Channel 0 cannot be chained.
	0 Channel Chaining is disabled. Channel Timer runs independently.
	1 Channel Chaining is enabled. Timer decrements on previous channel's timeout
0 T_EN	Timer Enable
	Enables or disables the Timer Channel
	0 Timer Channel is disabled
	1 Timer Channel is enabled

40.5 Functional description

40.5.1 Initialization

The following steps can be used to initialize the LPIT module

• Enable the protocol clock by setting the M_CEN bit in the MCR register.

NOTE

Writing to certain registers while M_CEN = 0 will lead to assertion of transfer error for that bus access. These registers are MSR, SETTEN, CLRTEN, TVAL, and TCTRL. Writing to CVAL and Reserved registers will generate a transfer error irrespective of M_CEN bit value. Reads to these registers can happen irrespective of M_CEN bit value.

- Wait for 4 protocol clock cycles to allow time for clock synchronization and reset deassertion.
- For each timer channel that is to be enabled, configure the timer mode of operation (MODE bits), Trigger source selection (TRG_SEL & TRG_SRC) and Trigger control bits (TROT, TSOT, TSOI bits) in the TCTRLn register.
- Configure the channels that are to be chained by setting the CHAIN bit in the corresponding channel's TCTRLn register.
- For channels configured in Compare Mode, set the timer timeout value by programming the appropriate value in TVAL register for those channels.
- Configure TIEn bits in MIER register for those channels which are required to generate interrupt on timer timeout.
- Configure the low power mode functionality of the module by setting the DBG_EN and DOZE_EN bits in the MCR register. This is common to all timer channels.
- Enable the channel timers by setting the corresponding T_EN bit in the corresponding channel's TCRTLn register.
- For channels configured in Capture Mode, the timer value can be read from TVALn register when channel timeout occurs.
- At any time, the current value of the timer for any channel can be read by reading the corresponding channel's CVALn register.
- The timer interrupt flag bits (TIFn) in MSR register get asserted on timer timeout. These bits can be cleared by writing '1' to them.

40.5.2 Timer Modes

The timer mode is configured by setting an appropriate value in the MODE bits in TCTRLn register. The timer modes supported are:

- <u>32-bit Periodic Counter:</u> In this mode the counter will load and then decrement down to zero. It will then set the timer interrupt flag and assert the output pre-trigger.
- <u>Dual 16-bit Periodic Counter:</u> In this mode, the counter will load and then the lower 16-bits will decrement down to zero, which will assert the output pre-trigger. The upper 16-bits will then decrement down to zero, which will negate the output pre-trigger and set the timer interrupt flag.
- <u>32-bit Trigger Accumulator:</u> In this mode, the counter will load on the first trigger rising edge and then decrement down to zero on each trigger rising edge. It will then set the timer interrupt flag and assert the output pre-trigger.
- <u>32-bit Trigger Input Capture:</u> In this mode, the counter will load with 0xFFFF_FFFF and then decrement down to zero. If a trigger rising edge is detected, it will store the inverse of the current counter value in the load value register, set the timer interrupt flag and assert the output pre-trigger.

The timer operation is further controlled by Trigger Control bits (TSOT, TSOI, TROT) which control the timer load, reload, start and restart of the timers.

NOTE

- The trigger output is asserted one Protocol Timer Clock cycle later than pre-trigger output. The trigger output and the pre-trigger output de-assert at the same time.
- The pre-trigger output is asserted for two clock cycles and trigger output is asserted for one clock cycle (except in 16-bit Periodic Counter mode where both pre-trigger and trigger are asserted for many cycles depending on TMR_VAL[31:16]).

40.5.3 Trigger Control for Timers

The TSOT, TROT, TSOI and TRG_SEL, TRG_SRC bits control how the trigger input affects the timer operation. The TRG_SEL selects the input trigger for the channel from all other channel's trigger outputs. The TRG_SRC further selects between the selected internal trigger and the external trigger input to the channel.

The selected trigger affects the timer operation based on TROT, TSOI & TSOT bits. The behavior due to these bits is as follows:

• If TSOI = 1, counter stops on TIF assertion. Requires trigger (if TSOT = 1) or T_EN rising edge (if TSOT = 0), to reload and decrement. If TSOI = 0, counter does not stop after timeout.

NXP Semiconductors

1025

Usage Guide

- If TROT = 1, counter is loaded on each trigger; else, counter is loaded on every T_EN rising edge or timeout rising edge (timeout not used in Capture modes).
- If TSOT = 1, counter will start to decrement on trigger. Subsequent triggers are ignored till a counter timeout. If TSOT = 0, counter decrements immediately from the next clock edge. TSOT has no effect when channel is Chained or in Capture mode.

These bits affect the timer operation differently in different timer modes:

- In 32-bit Periodic Counter and Dual 16-bit Periodic Counter modes, all bits (TSOT, TSOI & TROT) affect the timer operation as described above.
- In 32-bit Trigger Accumulator mode, only TSOI bit controls the timer function. TROT & TSOT bits have no effect on timer operation.
- In 32-bit Input Trigger Capture mode, TSOI and TROT bits control the timer function. TSOT bit has no effect on timer operation.

40.5.4 Channel Chaining

Individual timer channels can be chained together to achieve a larger value of timeout. Chaining the timer channel causes them to work in a 'nested loop' manner thereby leading to an effective timeout value of $TVAL_{CHn} \times (TVAL_{CHn-1} + 1)$.

The channels are chained by setting the CHAIN bit in corresponding channel's TCTRLn register. When a channel is chained, that channel's timer decrements on previous channel's timeout pulse, irrespective of the timer mode (MODE bits). The TSOT bit does not have any effect if the channel timer (Channel 'n') is chained to previous channel's timer (Channel 'n-1').

40.6 Usage Guide

40.6.1 Periodic timer/counter

LPIT typical usage is to generate periodic trigger pulses and interrupts.

Example: LPIT channel0 trigger a periodic interrupt every 1 second

- Enable the LPIT module clock;
- Reset the timer channels and registers;
- Setup timer operation in debug and doze modes and enable the module;
- Setup the channel counters operation mode to "32-bit Periodic Counter", and keep default values for the trigger source;

- Set timer period for channel 0 as 1 second;
- Enable channel0 interrupt;
- Starts the timer counting afer all configuration;
- In the channel interrupt rountine, clear the channel flag every 1 second.

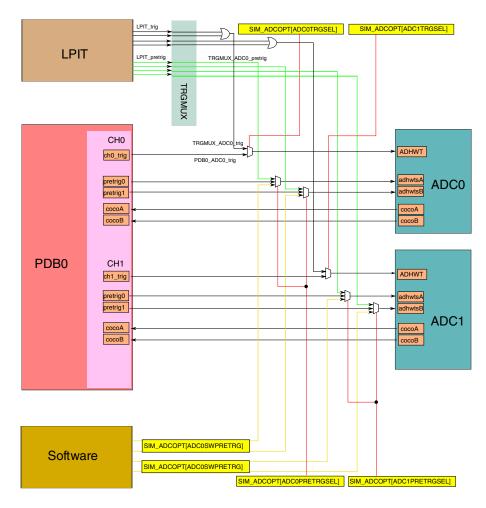
The following pseudo-code matches the described setup above:

```
CLOCK_EnableClock(LPIT0);
LPIT0_MCR |= LPIT_MCR_SW_RST_MASK;
LPIT0_MCR &= ~LPIT_MCR_SW_RST_MASK;
LPIT0_MCR |= (LPIT_MCR_DBG_EN(1) | LPIT_MCR_DOZE_EN(1) | LPIT_MCR_M_CEN_MASK);
LPIT0_TCTRL0 |= LPIT_TCTRL_MODE(0);
LPIT0_TVAL0 = ONE_SECOND_VALUE;
LPIT0_MIER |= LPIT_MIER_TIE0_MASK;
NVIC_EnableIRQ(LPIT0_IRQ);
LPIT0_SETTEN |= LPIT_SETTEN_SET_T_EN_0_MASK;
```

40.6.2 LPIT/ADC Trigger

The LPIT could be used as an alternate ADC hardware trigger source, whose implementation is via TRGMUX. Each LPIT channel supports one pre-trigger and one trigger. The LPIT channels are implemented based on independent counters. When used as ADC trigger source, the channel outputs are ORed together to generate the ADC hardware trigger. The following diagram shows an example of using LPIT triggering ADC0.

Usage Guide



Example: LPIT hardware trigger via TRGMUX for ADC conversion

- ADC module initialization and enable its hardware trigger;
- Enable the LPIT module clock;
- Reset the LPIT timer channels and registers;
- Setup timer operation in debug and doze modes and enable LPIT module;
- Setup the LPIT_CH0 and LPIT_CH1 counters mode to "32-bit Periodic Counter", and keep default values for the trigger source;
- Set timer period for LPIT_CH0 and LPIT_CH1, they are used as ADC pre-trigger delay;
- Starts the timer counting after all configuration;
- In SIM register, select TRGMUX output as ADC pre-trigger and trigger source;
- Configure LPIT_CH0 and LPIT_CH1 as ADC hardware trigger by TRGMUX;
- In the ADC interrupt routine, clear the COCO flag and read the conversion value. (If Rn is read, the COCO flag will be cleared automatically.)

The following pseudo-code matches the described setup above:

```
ADC_Config();
CLOCK_EnableClock(LPIT0);
LPIT0 MCR |= LPIT MCR SW RST MASK;
```

Chapter 40 Low-power Periodic Interrupt Timer (LPIT)

```
LPITO_MCR &= ~LPIT_MCR_SW_RST_MASK;

LPITO_MCR |= (LPIT_MCR_DBG_EN(1) | LPIT_MCR_DOZE_EN(1) | LPIT_MCR_M_CEN_MASK);

LPITO_TCTRLO |= LPIT_TCTRL MODE(0);

LPITO_TCTRL1 |= LPIT_TCTRL_MODE(0);

LPITO_TVAL0 = ADC_PRETRG_DELAY_VALUE1;

LPITO_TVAL1 = ADC_PRETRG_DELAY_VALUE2;

LPITO_SETTEN |= LPIT_SETTEN_SET_T_EN_O_MASK|LPIT_SETTEN_SET_T_EN_1_MASK;

SIM_ADCOPT |= SIM_ADCOPT_ADCOTRGSEL(1) | SIM_ADCOPT_ADCOPRETRGSEL(1);

TRGMUXO_ADCO = TRGMUX_TRGCFG_SELO(7) | TRGMUX_TRGCFG_SELO(8);
```

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Usage Guide

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Chapter 41 Pulse Width Timer (PWT)

41.1 Chip-specific information for this module

41.1.1 Instantiation Information

The Pulse Width Timer (PWT) module on this device consists of one 16-bit counter, which can be used to capture or measure the pulse width mapping on its input channels.

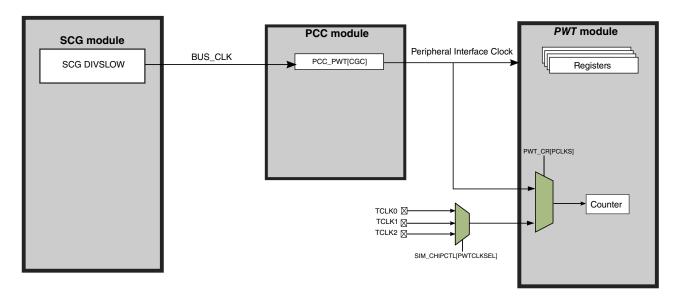
The counter of PWT has two selectable clocks sources, and support up to BUS_CLK with internal timer clock. PWT module supports programmable positive or negative pulse edges, and programmable interrupt generation upon pulse width values or counter overflow.

41.1.2 PWT Clocking Information

Two software selectable clock sources are available for input to pre-scaler divider of PWT module:

- Bus clock
- External clock from pins (TCLKx)

Peripheral Clocking - PWT



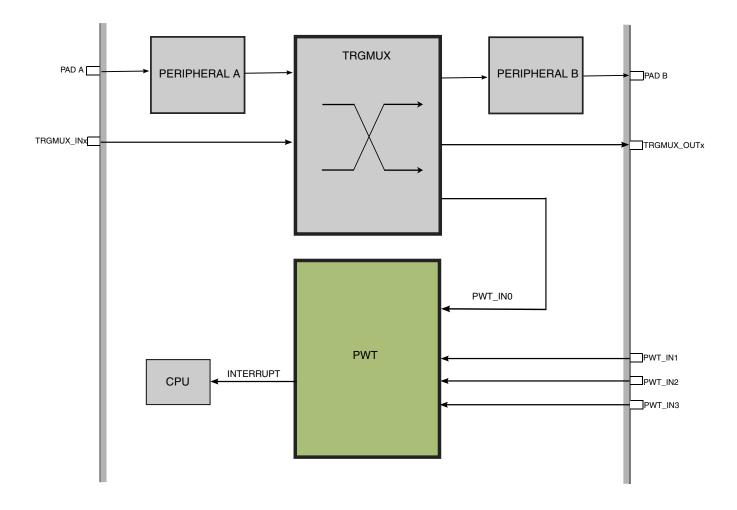
41.1.3 Inter-connectivity Information

PWT module has four input channels, which is connected as shown in the following table:

Table 41-1. PWT input connections

PWT input channel	Connection
0	TRGMUX output
1	PWT_IN1 pin
2	PWT_IN2 pin
3	PWT_IN3 pin

1033



41.2 Introduction

41.2.1 Features

The pulse width timer (PWT) includes the following features:

- Automatic measurement of pulse width with 16 bit resolution
- Separate positive and negative pulse width measurements
- Programmable measuring time between successive alternating edges, rising edges or falling edges
- Programmable pre-scaler from clock input as 16-bit counter time base
- Two selectable clock sources bus clock and alternative clock
- Four selectable pulse inputs
- Programmable interrupt generation upon pulse width value updated and counter overflows

41.2.2 Modes of operation

This module supports the following mode:

• Run Mode

When enabled, the pulse width timer module is active.

• Wait Mode

When enabled, the pulse width timer module is active and can perform the waking up function if the corresponding interrupt is enabled.

• Stop Mode

The pulse width timer module is halted when entering stop and the register contents and operating status is preserved. If stop exits with reset then the module resets. If stop exits with another source, the module resumes operation based on module status upon exit.

Active Background Mode

Upon entering BDM mode, the PWT suspends all counting and pulse edge detection until the microcontroller returns to normal user operating mode. Counting and edge detection resume from the suspended value when normal user operating mode returns as long as the PWTSR bit (PWT software reset) is not written to 1 and the PWT module is still enabled.

41.2.3 Block diagram

The following figure show the block diagram of the PWT.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018 1034 NXP Semiconductors

Chapter 41 Pulse Width Timer (PWT)

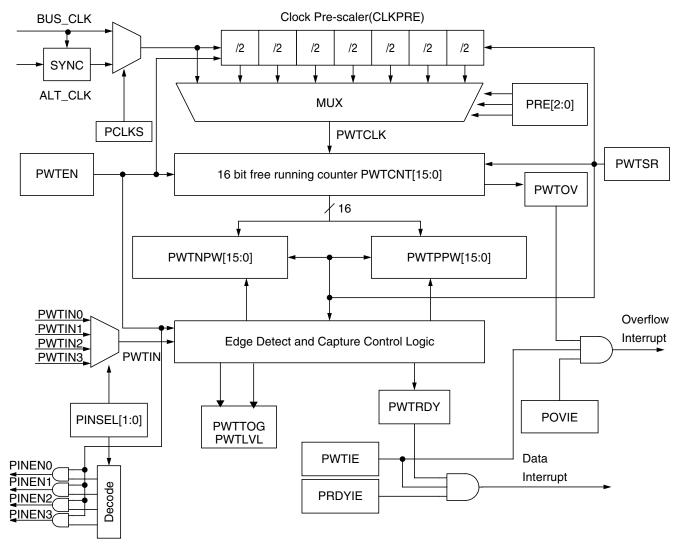


Figure 41-1. Pulse width timer (PWT) block diagram

41.3 External signal description

41.3.1 Overview

PWT has the following signal.

Table 41-2. PWT signal properties

Signal	Pullup	Description	I/O
PWTIN[3:0]	No	Pulse inputs	1
ALTCLK	No	Alternative clock source for the counter	I

41.3.2 PWTIN[3:0] — pulse width timer capture inputs

The input signals are pulse capture inputs which can come from internal or external. The PWT input is selected by PINSEL[1:0] to be routed to the pulse width timer. If the input comes from external and is selected as the PWT input, the input port is enabled for PWT function by PINSEL[1:0] automatically. The minimum pulse width to be measured is 1 PWTCLK cycle, any pulse narrower than this value is ignored by PWT module. The PWTCLK cycle time depends on the PWT clock source selection and pre-scaler rate setting.

41.3.3 ALTCLK— alternative clock source for counter

The PWT has an alternative clock input ALTCLK which can be selected as the clock source of the counter when the PCLKS bit is set. The ALTCLK input must be synchronized by the bus clock. Variations in duty cycle and clock jitter must also be accommodated so that the ALTCLK signal must not exceed one-fourth of the bus frequency. The ALTCLK pin can be shared with a general-purpose port pin. See the Pins and Connections chapter for the pin location and priority of this function.

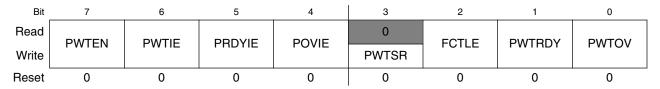
41.4 Memory Map and Register Descriptions

PWT memory map

Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page
4005_6000	Pulse Width Timer Control and Status Register (PWT_CS)	8	R/W	00h	41.4.1/1037
4005_6001	Pulse Width Timer Control Register (PWT_CR)	8	R/W	00h	41.4.2/1038
4005_6002	Pulse Width Timer Positive Pulse Width Register: High (PWT_PPH)	8	R	00h	41.4.3/1039
4005_6003	Pulse Width Timer Positive Pulse Width Register: Loq (PWT_PPL)	8	R	00h	41.4.4/1039
4005_6004	Pulse Width Timer Negative Pulse Width Register: High (PWT_NPH)	8	R	00h	41.4.5/1040
4005_6005	Pulse Width Timer Negative Pulse Width Register: Low (PWT_NPL)	8	R	00h	41.4.6/1040
4005_6006	Pulse Width Timer Counter Register: High (PWT_CNTH)	8	R	00h	41.4.7/1041
4005_6007	Pulse Width Timer Counter Register: Low (PWT_CNTL)	8	R	00h	41.4.8/1041

41.4.1 Pulse Width Timer Control and Status Register (PWT_CS)

Address: 4005_6000h base + 0h offset = 4005_6000h



PWT_CS field descriptions

Field	Description
7 PWTEN	PWT Module Enable
	Enables/disables the PWT module. To avoid unexpected behavior, do not change any PWT configurations as long as PWTEN is set.
	0 The PWT is disabled.
	1 The PWT is enabled.
6	PWT Module Interrupt Enable
PWTIE	Enables the PWT module to generate an interrupt.
	0 Disables the PWT to generate interrupt.
	1 Enables the PWT to generate interrupt.
5 PRDYIE	PWT Pulse Width Data Ready Interrupt Enable
	Enables/disables the PWT to generate an interrupt when PWTRDY is set as long as PWTIE is set.
	0 Disable PWT to generate interrupt when PWTRDY is set.
	1 Enable PWT to generate interrupt when PWTRDY is set.
4 POVIE	PWT Counter Overflow Interrupt Enable
	Enables/disables the PWT to generate an interrupt when PWTOV is set due to PWT counter overflow.
	0 Disable PWT to generate interrupt when PWTOV is set.
	1 Enable PWT to generate interrupt when PWTOV is set.
3 PWTSR	PWT Soft Reset
	Performs a soft reset to the PWT. This field always reads as 0.
	0 No action taken.
	1 Writing 1 to this field will perform soft reset to PWT.
2	First counter load enable after enable
FCTLE	This bit determines if the counter value should be loaded to the corresponding PWTx_PPW{H,L}, PWTx_NPW{H,L} after first enable.
	Do not load the first counter values to corresponding registers
	1 Load the first coutner value to corresponding registers depended by the PWTIN level

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

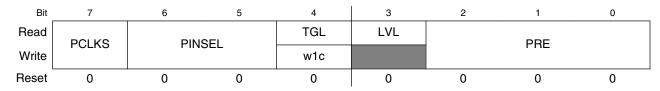
Memory Map and Register Descriptions

PWT_CS field descriptions (continued)

Field	Description
1 PWTRDY	PWT Pulse Width Valid
	Indicates that the PWT Pulse Width register(s) has been updated and is ready to be read. This field is cleared by reading PWTRDY and then writing 0 to PWTRDY bit when PWTRDY is set.Writing 1 to this field has no effect.
	0 PWT pulse width register(s) is not up-to-date.
	1 PWT pulse width register(s) has been updated.
0	PWT Counter Overflow
PWTOV	Indicates that the PWT counter has run from 0x0000_0xFFFF to 0x0000_0x0000. This field is cleared by writing 0 to PWTOV when PWTOV is set. Writing 1 to this field has no effect. If another overflow occurs when this field is being cleared, the clearing fails.
	0 PWT counter no overflow.
	1 PWT counter runs from 0xFFFF to 0x0000.

41.4.2 Pulse Width Timer Control Register (PWT_CR)

Address: 4005_6000h base + 1h offset = 4005_6001h



PWT_CR field descriptions

Field	Description
7 PCLKS	PWT Clock Source Selection
	Controls the selection of clock source for the PWT counter.
	0 BUS_CLK is selected as the clock source of PWT counter.
	1 Alternative clock is selected as the clock source of PWT counter.
6–5 PINSEL	PWT Pulse Inputs Selection
	Enables the corresponding PWT input port, if this PWT input comes from an external source.
	00 PWTIN[0] is enabled.
	01 PWTIN[1] is enabled.
	10 PWTIN[2] enabled.
	11 PWTIN[3] enabled.
4 TGL	PWTIN states Toggled from last state
. 32	This flag indicates if the selected PWTIN has toggled its state since last time this bit has cleared to 0.

Table continues on the next page...

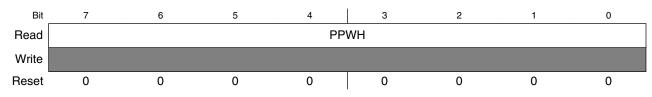
Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

PWT_CR field descriptions (continued)

Field	Description			
	0 The selected PWTIN hasn't changed its original states from last time.			
	1 The selected PWTIN has toggled its states.			
3	PWTIN Level when Overflows			
LVL				
	This Read Only bit signalizes the selected PWTIN states when the coutner overflows to read out.			
PRE	PWT Clock Prescaler (CLKPRE) Setting			
	Selects the value by which the clock is divided to clock the PWT counter.			
	000 Clock divided by 1.			
	001 Clock divided by 2.			
	010 Clock divided by 4.			
	011 Clock divided by 8.			
	100 Clock divided by 16.			
	101 Clock divided by 32.			
	110 Clock divided by 64.			
	111 Clock divided by 128.			

41.4.3 Pulse Width Timer Positive Pulse Width Register: High (PWT_PPH)

Address: 4005_6000h base + 2h offset = 4005_6002h



PWT_PPH field descriptions

Field	Description	
PPWH	Positive Pulse Width[15:8]	
	High byte of captured positive pulse width value.	

41.4.4 Pulse Width Timer Positive Pulse Width Register: Loq (PWT_PPL)

Address: 4005_6000h base + 3h offset = 4005_6003h



Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

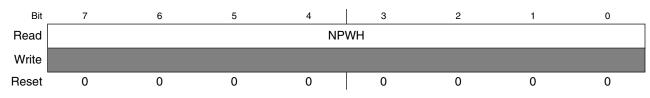
Memory Map and Register Descriptions

PWT_PPL field descriptions

Field	Description	
PPWL	Positive Pulse Width[7:0]	
	Low byte of captured positive pulse width value.	

41.4.5 Pulse Width Timer Negative Pulse Width Register: High (PWT_NPH)

Address: 4005_6000h base + 4h offset = 4005_6004h

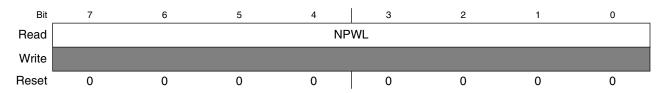


PWT_NPH field descriptions

Field	Description	
NPWH	Negative Pulse Width[15:8]	
	High byte of captured negative pulse width value.	

41.4.6 Pulse Width Timer Negative Pulse Width Register: Low (PWT_NPL)

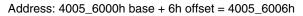
Address: 4005_6000h base + 5h offset = 4005_6005h

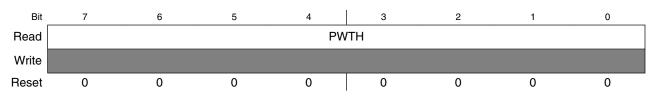


PWT_NPL field descriptions

Field	Description	
NPWL	Negative Pulse Width[7:0]	
	Low byte of captured negative pulse width value.	

41.4.7 Pulse Width Timer Counter Register: High (PWT_CNTH)



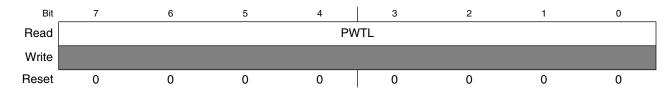


PWT_CNTH field descriptions

Field	Description	
PWTH	PWT counter[15:8]	
	High byte of PWT counter register.	

41.4.8 Pulse Width Timer Counter Register: Low (PWT_CNTL)

Address: 4005_6000h base + 7h offset = 4005_6007h



PWT_CNTL field descriptions

Field	Description	
PWTL	PWT counter[7:0]	
	Low byte of PWT counter register.	

41.5 Functional description

41.5.1 PWT counter and PWT clock pre-scaler

The pulse width timer (PWT) measures duration of a pulse or the period of a signal input to the PWTIN by a 16-bit free running counter (PWT_CNTH:L). There is a clock prescaler (CLKPRE) in PWT module that provides the frequency divided clock to the PWT_CNTH:L.. The clock pre-scaler can select clock input from bus clock and alternative clock by PWT_CR[PCLKS].

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Functional description

The PWT counter uses the frequency divided clock from CLKPRE for counter advancing. The frequency of pre-scaler is programmable as the clock frequency divided by 1, 2, 4, 8, 16, 32, 64, 128 (depending on the setting of PRE[2:0]).

When PWT_CNT is running, any edge to be measured after the trigger edge causes the value of the PWT_CNT to be uploaded to the appropriate pulse width registers. At the same time, PWT_CNT will be reset to \$0000 and the clock pre-scaler output will also be reset together. PWT_CNT will then start advancing again with the input clock. If the PWTxCNT runs from 0xFFFF to 0x0000, the PWTOV bit is set.

41.5.2 Edge detection and capture control

The edge detection and capture control part detects measurement trigger edges and controls when and which pulse width register(s) will be updated.

The edge detection logic determines from which edge appeared on PWTIN the pulse width starts to be measured, when and which pulse width registers should be updated.

The PWTIN can be selected from one of four sources by configuring PINSEL[1:0].

As soon as the PWT is enabled, the 16-bit free counter will begin to count up until a edge transistion on the selected PWTIN. Determined by PWT_CS[FCTLE] and PWTIN state, the counter contents can be uploaded to the corresponding registers.

If PWT_CS[FCTLE] is cleared to 0, the first 16-bit free counter content will just be ignored and not uploaded to neither PWT_PPH:L nor PWT_NPH:L. Otherwise, determined by current PWTIN state(as signalized by PWT_CR[LVL]), the counter content will be uploaded to PWT_PPH:L if PWT_CR[LVL] is 1 and PWT_NPH:L if PWT_CR[LVL] is 0.

In normal measurement, when the PWT_CS[PWTRDY] is set, software can then read out the positive pulse width and negative pulse width values from PWT_PPH:L and PWT_NPH:L respectively and the selected PWTIN duty ratio can then be calculated. The exception is when overflow happens, software need to check PWT_CR[TGL] and PWT_CR[LVL] to determine if it is low overflow(0 duty ratio), high overflow(100% duty ratio), toggled low overflow or toggled high overflow. Below table 1 shows the meaning:

Table 41-3. Abnormal PWTIN duty ratio

Flag	PWT_CR[TGL]	PWT_CR[LVL]	Description
PWT_CS[PWTOV]	0	0	Low overflow
	0	1	High overflow
	1	0	Toggled low overflow

Table continues on the next page...

Table 41-3. Abnormal PWTIN duty ratio (continued)

Flag	PWT_CR[TGL]	PWT_CR[LVL]	Description
	1	1	Toggled high overflow

The following figure illustrates the trigger edge detection and pulse width registers update of PWT.

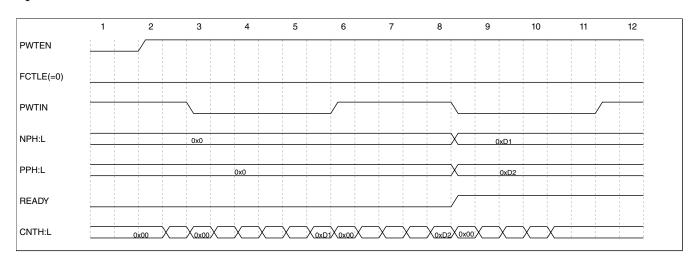


Figure 41-2. PWT normal measurement with FCTLE = 0

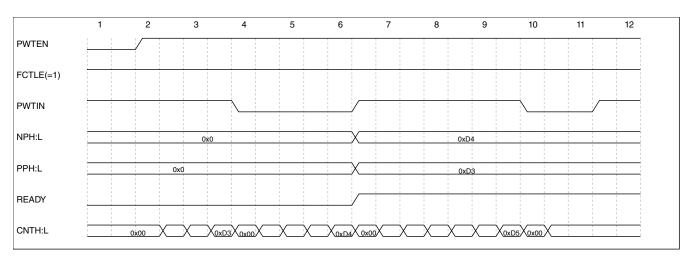


Figure 41-3. PWT normal measurement with FCTLE = 1

Functional description

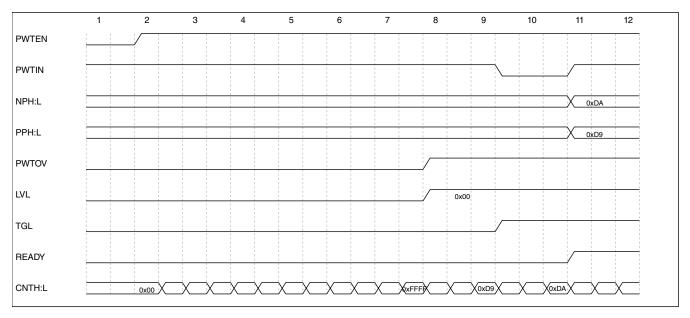


Figure 41-4. PWT measurement overflows at high level with FCTLE = 1

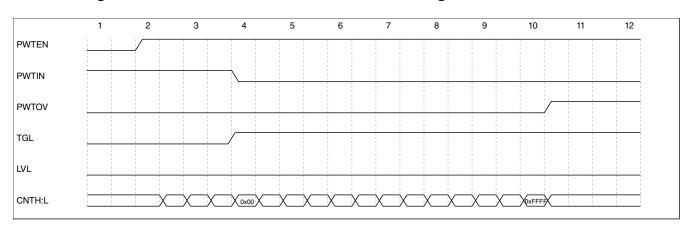


Figure 41-5. PWT measurement overflows with PWTIN toggles

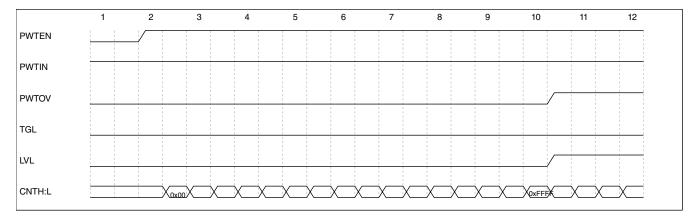


Figure 41-6. PWT measurement overflows without PWTIN toggles

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018 1044 **NXP Semiconductors**

1045

The PWTRDY flag bit indicates that the data can be read in PWTxPPH:L and/or PWTxNPH:L, whenever there is a valid edge transition happened on the selected PWTIN.

When PWTRDY bit is set, the updated pulse width register(s) transfers the data to corresponding 16-bit read buffer(s). The read value of pulse width registers actually comes from the corresponding read buffers, whenever the chip is in normal run mode or BDM mode. Reading followed by writing 0 to the PWTRDY flag clears this bit. Until the PWTRDY bit is cleared, the 16-bit read buffer(s) cannot be updated. But this does not affect the upload of pulse width registers from the PWT counter.

If another pulse measurement is completed and the pulse width registers are updated, the clearing of the PWTRDY flag fails, i.e., the PWTRDY will still be set, but the 16-bit read buffer(s) will be updated again as long as the action is cleared. The user should complete the pulse width data reading before clearing the PWTRDY flag to avoid missing data. This mechanism assures that the second pulse measurement will not be lost in case the MCU does not have enough time to read the first one ready for read. The mechanism is automatically restarted by an MCU reset , writing 1 to PWTSR bit or writing a 0 to PWTEN bit followed by writing a 1 to it.

The following figure illustrates the buffering mechanism of pulse width register:

Reset overview

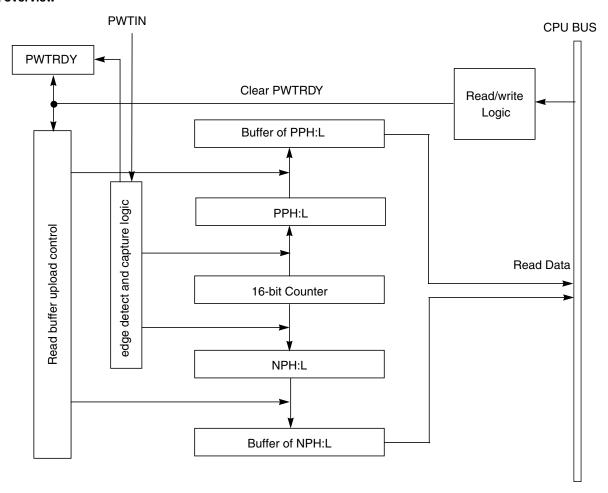


Figure 41-7. Buffering mechanism of pulse width register

When PWT completes any pulse width measurement, a signal is generated to reset PWTxCNTH:L and the clock pre-scaler output after the data has been uploaded to the pulse width registers.. To assure that there is no missing count, the PWTxCNTH:L and the clock pre-scaler output are reset in a bus clock cycle after the completion of a pulse width measurement.

41.6 Reset overview

41.6.1 Description of reset operation

PWT soft reset is built into PWT as a mechanism used to reset/restart the pulse width timer. The PWT soft reset is triggered by writing 1 to the PWTSR bit. (This bit always reads 0). Unlike reset by the CPU, the PWT reset does not restore everything in the PWT to its reset state. The following occurs

1. The PWT counter is set to 0x0000

1047

- 2. The 16-bit buffer of PWT counter is reset and the reading coherency mechanism is restarted
- 3. The PWT clock pre-scaler output is reset
- 4. The edge detection logic is reset
- 5. The capture logic is reset and the latching mechanism of pulse width registers is also restarted.
- 6. PWTxPPH, PWTxPPL, PWTxNPH, PWTxNPL are set to 0x00
- 7. PWTOV, PWTRDY, TGL and LVL status are set to 0
- 8. All other PWT register settings are not changed

Writing a 0 to PWTEN bit also has the above effects except that the reset state will be held until the PWTEN bit is set to 1.

41.7 Interrupts

41.7.1 Description of interrupt operation

The other major component of the PWT is the interrupts control logic. When the PWTOV bit and POVIE bit of PWTxCS are set, a PWT overflow interrupt can be generated. When PWTRDY bit and PRDYIE bit of PWTxCS are set, a pulse width data ready interrupt can be generated. The PWTIE bit of PWTxCS controls the interrupt generation of the PWT module. The functionality of the PWT is not affected while the interrupt is being generated.

41.7.2 Application examples

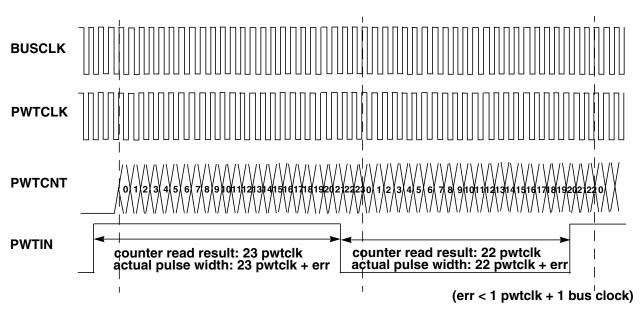


Figure 41-8. Example at PWTCLK is bus clock divided by 1

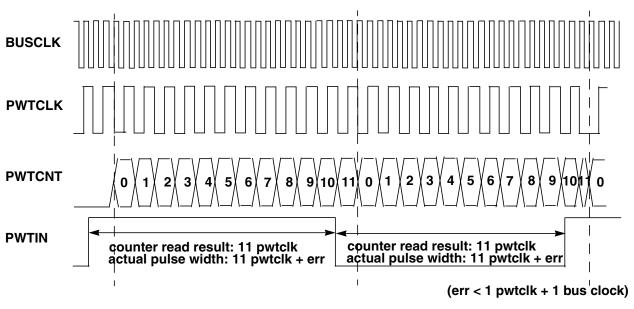


Figure 41-9. Example at PWTCLK is Bus Clock divided by 2

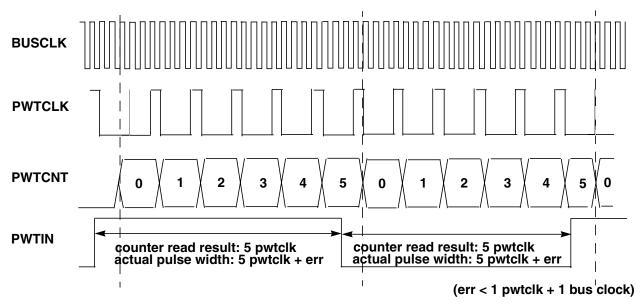


Figure 41-10. Example at PWTCLK is bus clock divided by 4

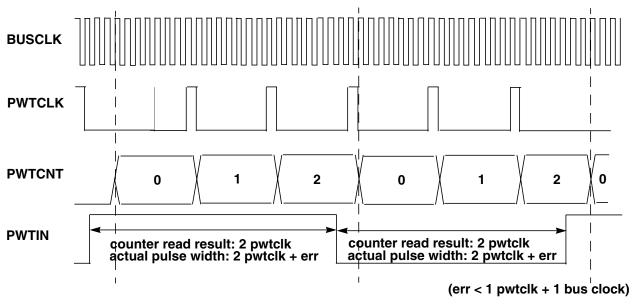


Figure 41-11. Example at PWTCLK is bus clock divided by 8

41.8 Initialization/Application information

Following are the recommended steps to initialize the PWT module:

- 1. Configure PWTxCR to select clock source, set pre-scaler rate, select PWT input pin and edge detection mode.
- 2. Set PWTIE, PRDYIE and POVIE bits in PWTxCS if corresponding interrupt is desired to be generated.
- 3. Set PWTEN bit in PWTxCS to enable the pulse width measurement.

Usage Guide

The step 1 and 2 can be sequential or not, but they must be completed before step 3 to ensure all settings are ready before pulse width measurement is enabled.

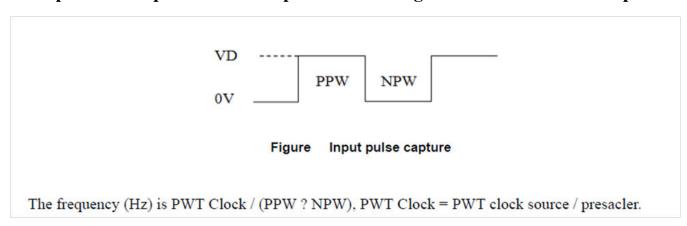
41.9 Usage Guide

PWT provides an accurate signal frequency measurement for both the positive and negative portions of a periodic signal, useful for applications such as motor control. In conjunction with a Pulse Width Modulated signal it can effectively be used to implement a highly accurate closed loop motor control system, or any other system in which it might be necessary to measure a periodic signal frequency and duty cycle, providing not only accuracy but also high flexibility.

41.9.1 Edge detection, capture control and period measurement

PWT typical usage is external signal input capture and time period measurement.

Example: PWT input channel 1 capture external signal and measure its time period



- Enable the PWT module clock;
- Reset the timer channels and registers;
- Configure not to load the first counter values to corresponding registers, enable the PWT interrupt;
- Select bus clock as clock source and enable PWT_IN1 as input source;
- Set the module enable bit to start PWT;
- Wait for the pulse width valid flag (PWTRDY) in interrupt routinue, then get the positive and negative value(PPW, NPW) to calculate the period.

The following pseudo-code matches the described setup above:

```
CLOCK_EnableClock(PWT);
PWT_CS|= PWT_CS_PWTSR_MASK;
PWT_CS|= PWT_CS_FCTLE(0)|PWT_CS_PWTIE_MASK|PWT_CS_PRDYIE_MASK;
```

Chapter 41 Pulse Width Timer (PWT)

1051

PWT_CS| = PWT_CR_PCLKS(0)|PWT_CR_PRE(0)|PWT_CR_PINSEL(1);
PWT_CS| = PWT_CS_PWTEN_MASK;
EnableIRQ(PWT_IRQ);

Usage Guide

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Chapter 42 Low Power Timer (LPTMR)

42.1 Chip-specific information for this module

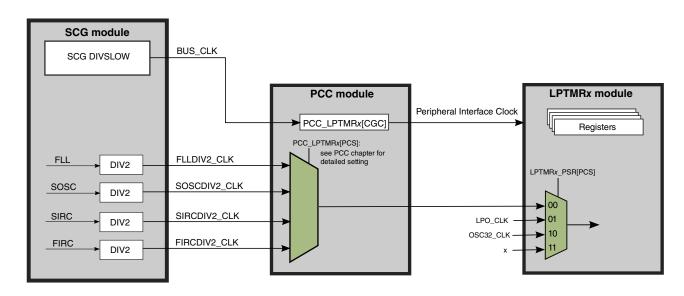
42.1.1 Instantiation Information

This device contains one LPTMR module with 1-channel, 16-bit pulse counter.

42.1.2 LPTMR Clocking Information

The following figure shows the input clock sources available for this module.

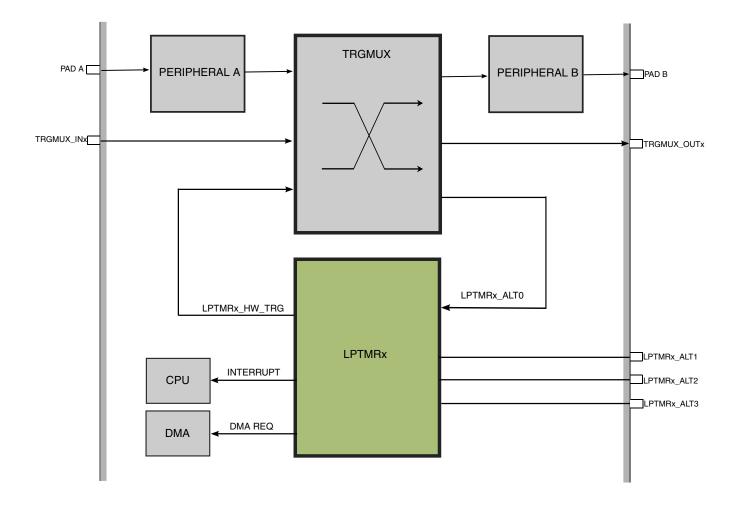
Peripheral Clocking - LPTMR



Inter-connectivity Information 42.1.3

The LPTMRx_CSR[TPS] bitfield configures the input source used in pulse counter mode. The following table shows the chip-specific input assignments for this bitfield.

LPTMRx_CSR[TPS]	Pulse counter input number	Chip input
00	0	TRGMUX output
01	1	LPTMR0_ALT1 pin
10	2	LPTMR0_ALT2 pin
11	3	LPTMR0_ALT3 pin



Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018 1054 **NXP Semiconductors**

1055

42.2 Introduction

The low-power timer (LPTMR) can be configured to operate as a time counter with optional prescaler, or as a pulse counter with optional glitch filter, across all power modes. It can also continue operating through most system reset events, allowing it to be used as a time of day counter.

42.2.1 Features

The features of the LPTMR module include:

- 16-bit time counter or pulse counter with compare
 - Optional interrupt can generate asynchronous wakeup from any low-power mode
 - Hardware trigger output
 - Counter supports free-running mode or reset on compare
- Configurable clock source for prescaler/glitch filter
- Configurable input source for pulse counter
 - Rising-edge or falling-edge

42.2.2 Modes of operation

The following table describes the operation of the LPTMR module in various modes.

Table 42-1. Modes of operation

Modes	Description
Run	The LPTMR operates normally.
Wait	The LPTMR continues to operate normally and can be configured to exit the low-power mode by generating an interrupt request.
Stop	The LPTMR continues to operate normally and can be configured to exit the low-power mode by generating an interrupt request.
Debug	The LPTMR operates normally in Pulse Counter mode, but the counter does not increment in Time Counter mode.

42.3 LPTMR signal descriptions

Table 42-2. LPTMR signal descriptions

Signal	I/O	Description
LPTMR_ALT <i>n</i>	I	Pulse Counter Input pin

42.3.1 Detailed signal descriptions

Table 42-3. LPTMR interface—detailed signal descriptions

Signal	I/O	Description		
LPTMR_ALT <i>n</i>	I	Pulse Counter Input		
		The LPTMR can select one	of the input pins to be used in Pulse Counter mode.	
		State meaning	State meaning Assertion—If configured for pulse counter mode with active-high input, then assertion causes the CNR to increment.	
			Deassertion—If configured for pulse counter mode with active-low input, then deassertion causes the CNR to increment.	
		Timing	Assertion or deassertion may occur at any time; input may assert asynchronously to the bus clock.	

42.4 Memory map and register definition

NOTE

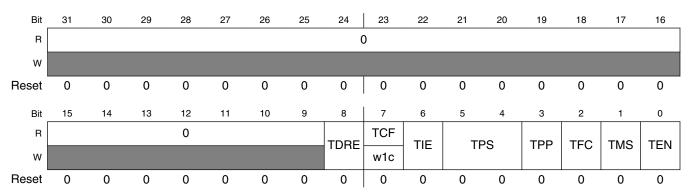
The LPTMR registers are reset only on a POR or LVD event. See LPTMR power and reset for more details.

LPTMR memory map

Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page
4004_0000	Low Power Timer Control Status Register (LPTMR0_CSR)	32	R/W	0000_0000h	42.4.1/1057
4004_0004	Low Power Timer Prescale Register (LPTMR0_PSR)	32	R/W	0000_0000h	42.4.2/1058
4004_0008	Low Power Timer Compare Register (LPTMR0_CMR)	32	R/W	0000_0000h	42.4.3/1060
4004_000C	Low Power Timer Counter Register (LPTMR0_CNR)	32	R/W	0000_0000h	42.4.4/1060

42.4.1 Low Power Timer Control Status Register (LPTMRx_CSR)

Address: 4004_0000h base + 0h offset = 4004_0000h



LPTMRx_CSR field descriptions

Field	Description
31–9	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
8 TDRE	Timer DMA Request Enable
	When TDRE is set, the LPTMR DMA Request is generated whenever TCF is also set and the TCF is cleared when the DMA Controller is done.
	0 Timer DMA Request disabled.
	1 Timer DMA Request enabled.
7 TCF	Timer Compare Flag
101	TCF is set when the LPTMR is enabled and the CNR equals the CMR and increments. TCF is cleared when the LPTMR is disabled or a logic 1 is written to it.
	0 The value of CNR is not equal to CMR and increments.
	1 The value of CNR is equal to CMR and increments.
6 TIE	Timer Interrupt Enable
115	When TIE is set, the LPTMR Interrupt is generated whenever TCF is also set.
	0 Timer interrupt disabled.
	1 Timer interrupt enabled.
5–4 TPS	Timer Pin Select
	Configures the input source to be used in Pulse Counter mode. TPS must be altered only when the LPTMR is disabled. The input connections vary by device. See the chip configuration information about connections to these inputs.
	00 Pulse counter input 0 is selected.
	01 Pulse counter input 1 is selected.
	10 Pulse counter input 2 is selected.
	11 Pulse counter input 3 is selected.

Table continues on the next page...

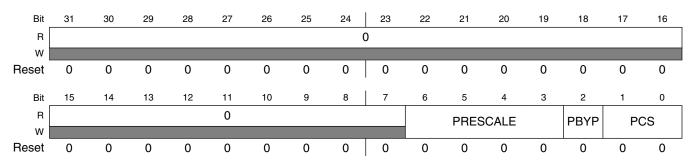
Memory map and register definition

LPTMRx_CSR field descriptions (continued)

Field	Description
3 TPP	Timer Pin Polarity
	Configures the polarity of the input source in Pulse Counter mode. TPP must be changed only when the LPTMR is disabled.
	0 Pulse Counter input source is active-high, and the CNR will increment on the rising-edge.
	1 Pulse Counter input source is active-low, and the CNR will increment on the falling-edge.
2 TFC	Timer Free-Running Counter
	When clear, TFC configures the CNR to reset whenever TCF is set. When set, TFC configures the CNR to reset on overflow. TFC must be altered only when the LPTMR is disabled.
	0 CNR is reset whenever TCF is set.
	1 CNR is reset on overflow.
1	Timer Mode Select
TMS	Configures the mode of the LPTMR. TMS must be altered only when the LPTMR is disabled.
	0 Time Counter mode.
	1 Pulse Counter mode.
0 TEN	Timer Enable
	When TEN is clear, it resets the LPTMR internal logic, including the CNR and TCF. When TEN is set, the LPTMR is enabled. While writing 1 to this field, CSR[5:1] must not be altered.
	0 LPTMR is disabled and internal logic is reset.
	1 LPTMR is enabled.

42.4.2 Low Power Timer Prescale Register (LPTMRx_PSR)

Address: 4004_0000h base + 4h offset = 4004_0004h



LPTMRx_PSR field descriptions

Field	Description
31–7 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
6–3 PRESCALE	Prescale Value

Table continues on the next page...

LPTMRx_PSR field descriptions (continued)

Field	Description
	Configures the size of the Prescaler in Time Counter mode or width of the glitch filter in Pulse Counter
	mode. PRESCALE must be altered only when the LPTMR is disabled.
	0000 Prescaler divides the prescaler clock by 2; glitch filter does not support this configuration.
	O001 Prescaler divides the prescaler clock by 4; glitch filter recognizes change on input pin after 2 rising clock edges.
	O010 Prescaler divides the prescaler clock by 8; glitch filter recognizes change on input pin after 4 rising clock edges.
	O011 Prescaler divides the prescaler clock by 16; glitch filter recognizes change on input pin after 8 rising clock edges.
	O100 Prescaler divides the prescaler clock by 32; glitch filter recognizes change on input pin after 16 rising clock edges.
	O101 Prescaler divides the prescaler clock by 64; glitch filter recognizes change on input pin after 32 rising clock edges.
	O110 Prescaler divides the prescaler clock by 128; glitch filter recognizes change on input pin after 64 rising clock edges.
	O111 Prescaler divides the prescaler clock by 256; glitch filter recognizes change on input pin after 128 rising clock edges.
	1000 Prescaler divides the prescaler clock by 512; glitch filter recognizes change on input pin after 256 rising clock edges.
	1001 Prescaler divides the prescaler clock by 1024; glitch filter recognizes change on input pin after 512 rising clock edges.
	1010 Prescaler divides the prescaler clock by 2048; glitch filter recognizes change on input pin after 1024 rising clock edges.
	1011 Prescaler divides the prescaler clock by 4096; glitch filter recognizes change on input pin after 2048 rising clock edges.
	1100 Prescaler divides the prescaler clock by 8192; glitch filter recognizes change on input pin after 4096 rising clock edges.
	Prescaler divides the prescaler clock by 16,384; glitch filter recognizes change on input pin after 8192 rising clock edges.
	Prescaler divides the prescaler clock by 32,768; glitch filter recognizes change on input pin after 16,384 rising clock edges.
	Prescaler divides the prescaler clock by 65,536; glitch filter recognizes change on input pin after 32,768 rising clock edges.
2 PBYP	Prescaler Bypass
FBIF	When PBYP is set, the selected prescaler clock in Time Counter mode or selected input source in Pulse Counter mode directly clocks the CNR. When PBYP is clear, the CNR is clocked by the output of the prescaler/glitch filter. PBYP must be altered only when the LPTMR is disabled.
	0 Prescaler/glitch filter is enabled.1 Prescaler/glitch filter is bypassed.
PCS	Prescaler Clock Select
	Selects the clock to be used by the LPTMR prescaler/glitch filter. PCS must be altered only when the LPTMR is disabled. The clock connections vary by device.
	NOTE: See the chip configuration details for information on the connections to these inputs.
	00 Prescaler/glitch filter clock 0 selected.01 Prescaler/glitch filter clock 1 selected.
'	

Table continues on the next page...

Functional description

LPTMRx_PSR field descriptions (continued)

Field	Description
	0 Prescaler/glitch filter clock 2 selected.
	1 Prescaler/glitch filter clock 3 selected.

42.4.3 Low Power Timer Compare Register (LPTMRx_CMR)

Address: 4004_0000h base + 8h offset = 4004_0008h

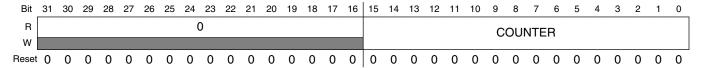


LPTMRx_CMR field descriptions

Field	Description
31–16	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
COMPARE	Compare Value
	When the LPTMR is enabled and the CNR equals the value in the CMR and increments, TCF is set and the hardware trigger asserts until the next time the CNR increments. If the CMR is 0, the hardware trigger will remain asserted until the LPTMR is disabled. If the LPTMR is enabled, the CMR must be altered only when TCF is set.

42.4.4 Low Power Timer Counter Register (LPTMRx_CNR)

Address: 4004_0000h base + Ch offset = 4004_000Ch



LPTMRx_CNR field descriptions

Field	Description
31–16 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
	Counter Value
	The CNR returns the current value of the LPTMR counter at the time this register was last written.

42.5 Functional description

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

42.5.1 LPTMR power and reset

The LPTMR remains powered in all power modes. If the LPTMR is not required to remain operating during a low-power mode, then it must be disabled before entering the mode.

The LPTMR is reset only on global Power On Reset (POR) or Low Voltage Detect (LVD). When configuring the LPTMR registers, the CSR must be initially written with the timer disabled, before configuring the PSR and CMR. Then, CSR[TIE] must be set as the last step in the initialization. This ensures the LPTMR is configured correctly and the LPTMR counter is reset to zero following a warm reset.

42.5.2 LPTMR clocking

The LPTMR prescaler/glitch filter can be clocked by one of the four clocks. The clock source must be enabled before the LPTMR is enabled.

NOTE

The clock source selected may need to be configured to remain enabled in low-power modes, otherwise the LPTMR will not operate during low-power modes.

In Pulse Counter mode with the prescaler/glitch filter bypassed, the selected input source directly clocks the CNR and no other clock source is required. To minimize power in this case, configure the prescaler clock source for a clock that is not toggling.

NOTE

The clock source or pulse input source selected for the LPTMR should not exceed the frequency f_{LPTMR} defined in the device datasheet.

42.5.3 LPTMR prescaler/glitch filter

The LPTMR prescaler and glitch filter share the same logic which operates as a prescaler in Time Counter mode and as a glitch filter in Pulse Counter mode.

NOTE

The prescaler/glitch filter configuration must not be altered when the LPTMR is enabled.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

42.5.3.1 Prescaler enabled

In Time Counter mode, when the prescaler is enabled, the output of the prescaler directly clocks the CNR. When the LPTMR is enabled, the CNR will increment every 2^2 to 2^{16} prescaler clock cycles. After the LPTMR is enabled, the first increment of the CNR will take an additional one or two prescaler clock cycles due to synchronization logic.

42.5.3.2 Prescaler bypassed

In Time Counter mode, when the prescaler is bypassed, the selected prescaler clock increments the CNR on every clock cycle. When the LPTMR is enabled, the first increment will take an additional one or two prescaler clock cycles due to synchronization logic.

42.5.3.3 Glitch filter

In Pulse Counter mode, when the glitch filter is enabled, the output of the glitch filter directly clocks the CNR. When the LPTMR is first enabled, the output of the glitch filter is asserted, that is, logic 1 for active-high and logic 0 for active-low. The following table shows the change in glitch filter output with the selected input source.

If	Then
The selected input source remains deasserted for at least 2 ¹ to 2 ¹⁵ consecutive prescaler clock rising edges	The glitch filter output will also deassert.
The selected input source remains asserted for at least 2 ¹ to 2 ¹⁵ consecutive prescaler clock rising-edges	The glitch filter output will also assert.

NOTE

The input is only sampled on the rising clock edge.

The CNR will increment each time the glitch filter output asserts. In Pulse Counter mode, the maximum rate at which the CNR can increment is once every 2^2 to 2^{16} prescaler clock edges. When first enabled, the glitch filter will wait an additional one or two prescaler clock edges due to synchronization logic.

1063

42.5.3.4 Glitch filter bypassed

In Pulse Counter mode, when the glitch filter is bypassed, the selected input source increments the CNR every time it asserts. Before the LPTMR is first enabled, the selected input source is forced to be asserted. This prevents the CNR from incrementing if the selected input source is already asserted when the LPTMR is first enabled.

42.5.4 LPTMR compare

When the CNR equals the value of the CMR and increments, the following events occur:

- CSR[TCF] is set.
- LPTMR interrupt is generated if CSR[TIE] is also set.
- LPTMR hardware trigger is generated.
- CNR is reset if CSR[TFC] is clear.

When the LPTMR is enabled, the CMR can be altered only when CSR[TCF] is set. When updating the CMR, the CMR must be written and CSR[TCF] must be cleared before the LPTMR counter has incremented past the new LPTMR compare value.

42.5.5 LPTMR counter

The CNR increments by one on every:

- Prescaler clock in Time Counter mode with prescaler bypassed
- Prescaler output in Time Counter mode with prescaler enabled
- Input source assertion in Pulse Counter mode with glitch filter bypassed
- Glitch filter output in Pulse Counter mode with glitch filter enabled

The CNR is reset when the LPTMR is disabled or if the counter register overflows. If CSR[TFC] is cleared, then the CNR is also reset whenever CSR[TCF] is set.

When the core is halted in Debug mode:

- If configured for Pulse Counter mode, the CNR continues incrementing.
- If configured for Time Counter mode, the CNR stops incrementing.

The CNR cannot be initialized, but can be read at any time. On each read of the CNR, software must first write to the CNR with any value. This will synchronize and register the current value of the CNR into a temporary register. The contents of the temporary register are returned on each read of the CNR.

When reading the CNR, the bus clock must be at least two times faster than the rate at which the LPTMR counter is incrementing, otherwise incorrect data may be returned.

42.5.6 LPTMR hardware trigger

The LPTMR hardware trigger asserts at the same time the CSR[TCF] is set and can be used to trigger hardware events in other peripherals without software intervention. The hardware trigger is always enabled.

When	Then
The CMR is set to 0 with CSR[TFC] clear	The LPTMR hardware trigger will assert on the first compare and does not deassert.
The CMR is set to a nonzero value, or, if CSR[TFC] is set	The LPTMR hardware trigger will assert on each compare and deassert on the following increment of the CNR.

42.5.7 LPTMR interrupt

The LPTMR interrupt is generated whenever CSR[TIE] and CSR[TCF] are set. CSR[TCF] is cleared by disabling the LPTMR or by writing a logic 1 to it.

CSR[TIE] can be altered and CSR[TCF] can be cleared while the LPTMR is enabled.

The LPTMR interrupt is generated asynchronously to the system clock and can be used to generate a wakeup from any low-power mode, provided the LPTMR is enabled as a wakeup source.

42.6 Usage Guide

LPTMR is very useful in low power situations. It can be used as a wake-up timer to wake the MCU out of sleep modes after a certain amount of time. If used as pulse counter mode with the glitch filter enabled, then there is no need for a clock to be on. The MCU can wakeup based on counting pulses.

42.6.1 Time Counter mode

The typical usage of LPTMR is as Time Counter mode to generate periodic trigger pulses and interrupts.

Example: LPTMR trigger a periodic interrupt every 1 second

• Enable the LPTMR module clock;

1065

- Configure LPTMR to Timer counter mode by default, use LPO 128K as clock source, bypass the prescaler;
- Set the compare value register to 1 second value;
- Enable timer interrupt;
- Starts the timer counting after all configuration;
- In the interrupt routine, clear the channel compare flag TCF every 1 second.

The following pseudo-code matches the described setup above:

```
CLOCK_EnableClock(LPTMR0);
LPTMR0_CSR = 0;
LPTMR0_PSR |= LPTMR_PSR_PBYP_MASK|LPTMR_PSR_PCS(1);
LPTMR0_CMR = ONE_SECOND_VALUE;
LPTMR0_CSR |= LPTMR_CSR_TIE_MASK;
EnableTRQ(LPTMR0_IRQn);
LPTMR0_CSR |= LPTMR_CSR_TEN_MASK;
```

42.6.2 Pulse Counter mode

LPTMR another option is used as Pulse Counter mode to count the input pulses.

Example: LPTMR count the input pulses on LPTMR0_ALT1 pin

- Enable the LPTMR module clock;
- Configure LPTMR to Pulse counter mode, use LPO 128K as clock source, bypass the glitch filter
- Set the compare value register to the value you want to compare the numbers of pulse
- Enable the pulse counter input enable on LPTMR0_ALT1
- Enable timer interrupt
- Starts the pulse counting after all configuration;
- In the interrupt routine, clear the channel compare flag TCF when the counter reaches the value in compare register;

The following pseudo-code matches the described setup above:

```
CLOCK_EnableClock(LPTMR0);
LPTMR0_CSR |= LPTMR_CSR_TPS(1) | LPTMR_CSR_TMS_MASK;
LPTMR0_PSR |= LPTMR_PSR_PBYP_MASK|LPTMR_PSR_PCS(1);
LPTMR0_CMR = PULSE_COMPARE_VALUE;
LPTMR0_CSR |= LPTMR_CSR_TIE_MASK;
EnableIRQ(LPTMR0_IRQn);
LPTMR0_CSR |= LPTMR_CSR_TEN_MASK;
```

Usage Guide

Chapter 43 Real Time Clock (SRTC)

43.1 Chip-specific information for this module

43.1.1 RTC Instantiation

Low range OSC32 (30–40 kHz) will be used as the clock source option for RTC.

NOTE

The wakeup pin is not available for RTC on this device, therefore the related register bitfields are not applicable (e.g. RTC_CR[WPS], RTC_CR[WPE], and RTC_IER[WPON]).

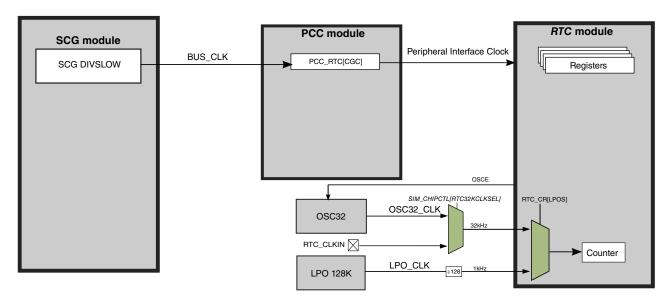
NOTE

Also there is no integrated capacitor for this device, therefore no tunable capacitors (included in the crystal oscillator) can be configured by software.

43.1.2 RTC Clocking Information

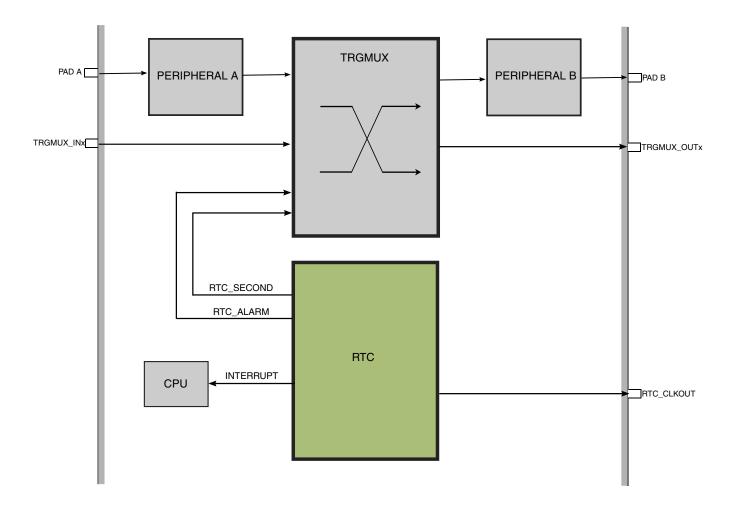
The following figure shows the input clock sources available for this module.

Peripheral Clocking - RTC



43.1.3 Inter-connectivity Information

The SRTC inter-connectivity is shown in following diagram..



43.2 Introduction

43.2.1 Features

The RTC module features include:

- 32-bit seconds counter with roll-over protection and 32-bit alarm
- 16-bit prescaler with compensation that can correct errors between 0.12 ppm and 3906 ppm
- Option to increment prescaler using the LPO (prescaler increments by 32 every clock edge)
- Register write protection

Register definition

- Lock register requires POR or software reset to enable write access
- Access control registers require system reset to enable read and/or write access
- Configurable 1, 2, 4, 8, 16, 32, 64 or 128 Hz square wave output with optional interrupt

43.2.2 Modes of operation

The RTC remains functional in all low power modes and can generate an interrupt to exit any low power mode.

43.2.3 RTC signal descriptions

Table 43-1. RTC signal descriptions

Signal	Description	I/O
	Prescaler square-wave output or 32kHz crystal clock	0

43.2.3.1 RTC clock output

The RTC_CLKOUT signal can output either a square wave prescaler output (configurable to 1, 2, 4, 8, 16, 32, 64 or 128 Hz) or the 32 kHz crystal clock.

43.3 Register definition

All registers must be accessed using 32-bit writes and all register accesses incur three wait states.

Write accesses to any register by non-supervisor mode software, when the supervisor access bit in the control register is clear, will terminate with a bus error.

Read accesses by non-supervisor mode software complete as normal.

Writing to a register protected by the write access register or lock register does not generate a bus error, but the write will not complete.

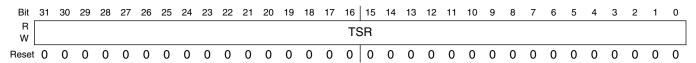
Reading a register protected by the read access register does not generate a bus error, but the register will read zero.

RTC memory map

Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page
4003_D000	RTC Time Seconds Register (RTC_TSR)	32	R/W	0000_0000h	43.3.1/1071
4003_D004	RTC Time Prescaler Register (RTC_TPR)	32	R/W	0000_0000h	43.3.2/1071
4003_D008	RTC Time Alarm Register (RTC_TAR)	32	R/W	0000_0000h	43.3.3/1072
4003_D00C	RTC Time Compensation Register (RTC_TCR)	32	R/W	0000_0000h	43.3.4/1072
4003_D010	RTC Control Register (RTC_CR)	32	R/W	0000_0000h	43.3.5/1074
4003_D014	RTC Status Register (RTC_SR)	32	R/W	0000_0001h	43.3.6/1076
4003_D018	RTC Lock Register (RTC_LR)	32	R/W	0000_00FFh	43.3.7/1077
4003_D01C	RTC Interrupt Enable Register (RTC_IER)	32	R/W	0000_0007h	43.3.8/1078
4003_D800	RTC Write Access Register (RTC_WAR)	32	R/W	0000_00FFh	43.3.9/1080
4003_D804	RTC Read Access Register (RTC_RAR)	32	R/W	0000_00FFh	43.3.10/ 1081

43.3.1 RTC Time Seconds Register (RTC_TSR)

Address: 4003_D000h base + 0h offset = 4003_D000h

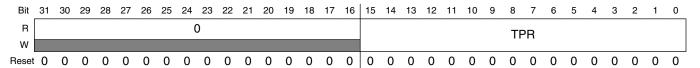


RTC_TSR field descriptions

Field	Description
TSR	Time Seconds Register
	When the time counter is enabled, the TSR is read only and increments once a second provided SR[TOF] or SR[TIF] are not set. The time counter will read as zero when SR[TOF] or SR[TIF] are set. When the time counter is disabled, the TSR can be read or written. Writing to the TSR when the time counter is disabled will clear the SR[TOF] and/or the SR[TIF]. Writing to TSR with zero is supported, but not recommended because TSR will read as zero when SR[TIF] or SR[TOF] are set (indicating the time is invalid).

43.3.2 RTC Time Prescaler Register (RTC_TPR)

Address: 4003_D000h base + 4h offset = 4003_D004h



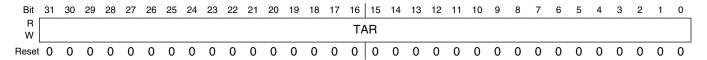
Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

RTC_TPR field descriptions

Field	Description
31–16 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
TPR	Time Prescaler Register When the time counter is enabled, the TPR is read only and increments every 32.768 kHz clock cycle. The time counter will read as zero when SR[TOF] or SR[TIF] are set. When the time counter is disabled, the TPR can be read or written. The TSR[TSR] increments when bit 14 of the TPR transitions from a logic one to a logic zero.

43.3.3 RTC Time Alarm Register (RTC_TAR)

Address: 4003_D000h base + 8h offset = 4003_D008h

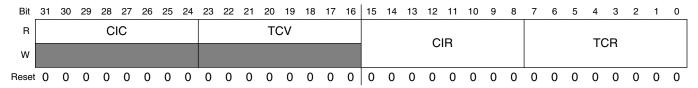


RTC_TAR field descriptions

Field	Description
	Time Alarm Register When the time counter is enabled, the SR[TAF] is set whenever the TAR[TAR] equals the TSR[TSR] and the TSR[TSR] increments. Writing to the TAR clears the SR[TAF].

43.3.4 RTC Time Compensation Register (RTC_TCR)

Address: 4003_D000h base + Ch offset = 4003_D00Ch



RTC_TCR field descriptions

Field	Description
31–24 CIC	Compensation Interval Counter
	Current value of the compensation interval counter. If the compensation interval counter equals zero then it is loaded with the contents of the CIR. If the CIC does not equal zero then it is decremented once a second.
23–16 TCV	Time Compensation Value

Table continues on the next page...

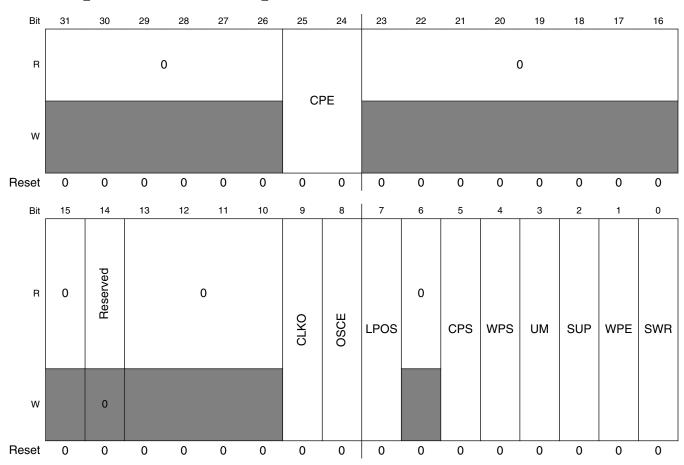
Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

RTC_TCR field descriptions (continued)

Field	Description		
	Current value used by the compensation logic for the present second interval. Updated once a second if the CIC equals 0 with the contents of the TCR field. If the CIC does not equal zero then it is loaded with zero (compensation is not enabled for that second increment).		
15–8 CIR	Compensation Interval Register Configures the compensation interval in seconds from 1 to 256 to control how frequently the TCR should adjust the number of 32.768 kHz cycles in each second. The value written should be one less than the number of seconds. For example, write zero to configure for a compensation interval of one second. This register is double buffered and writes do not take affect until the end of the current compensation interval.		
TCR	Time Compensation Register Configures the number of 32.768 kHz clock cycles in each second. This register is double buffered and writes do not take affect until the end of the current compensation interval. 80h Time Prescaler Register overflows every 32896 clock cycles FFh Time Prescaler Register overflows every 32769 clock cycles. 00h Time Prescaler Register overflows every 32768 clock cycles. 01h Time Prescaler Register overflows every 32767 clock cycles 7Fh Time Prescaler Register overflows every 32641 clock cycles.		

43.3.5 RTC Control Register (RTC_CR)

Address: 4003_D000h base + 10h offset = 4003_D010h



RTC_CR field descriptions

Field	Description		
31–26 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.		
25–24 CPE	Clock Pin Enable		
	NOTE: The CPE field should be configured to 01 or 11 (i.e. CPE[0] = 1), if we want the RTC_CLKOUT signal as output.		
	 00 RTC_CLKOUT is disabled. 01 RTC_CLKOUT is enabled. 10 Reserved. 11 Reserved. 		
23–15 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.		
14 Reserved	This field is reserved. It must always be written to 0.		

Table continues on the next page...

RTC_CR field descriptions (continued)

Field	Description
13–10 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
9	Clock Output
CLKO	0 The 32 kHz clock is allowed to output on RTC_CLKOUT.
	1 The 32 kHz clock is not allowed to output on RTC_CLKOUT.
8 OSCE	Oscillator Enable
	0 32.768 kHz oscillator is disabled.
	1 32.768 kHz oscillator is enabled. After setting this bit, wait the oscillator startup time before enabling the time counter to allow the 32.768 kHz clock time to stabilize.
7 LPOS	LPO Select
LPOS	When set, the RTC prescaler increments using the LPO clock and not the RTC 32 kHz crystal clock. The LPO increments the prescaler from bit TPR[5] (TPR[4:0] are ignored), supporting close to 1 second increment of the seconds register. Although compensation is supported when clocked from the LPO, TCR[4:0] of the compensation register are also ignored and only TCR[7:5] set the compensation value (can overflow after 1020 to 1027 cycles).
	 0 RTC prescaler increments using 32 kHz crystal. 1 RTC prescaler increments using LPO, bits [4:0] of the prescaler are bypassed.
6 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
5 CPS	Clock Pin Select
UF3	 The prescaler output clock (as configured by TSIC) is output on RTC_CLKOUT. The RTC 32kHz crystal clock is output on RTC_CLKOUT.
4	Wakeup Pin Select
WPS	The wakeup pin is optional and not available on all devices.
	0 Wakeup pin asserts (active low, open drain) if the RTC interrupt asserts or the wakeup pin is turned on.
	1 Wakeup pin instead outputs the RTC 32kHz clock, provided the wakeup pin is turned on and the 32kHz clock is output to other peripherals.
3	Update Mode
UM	Allows SR[TCE] to be written even when the Status Register is locked. When set, the SR[TCE] can always be written if the SR[TIF] or SR[TOF] are set or if the SR[TCE] is clear.
	0 Registers cannot be written when locked.
	1 Registers can be written when locked under limited conditions.
2 SUP	Supervisor Access
	0 Non-supervisor mode write accesses are not supported and generate a bus error.
	1 Non-supervisor mode write accesses are supported.
1 WPE	Wakeup Pin Enable
	The wakeup pin is optional and not available on all devices.

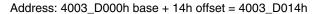
Table continues on the next page...

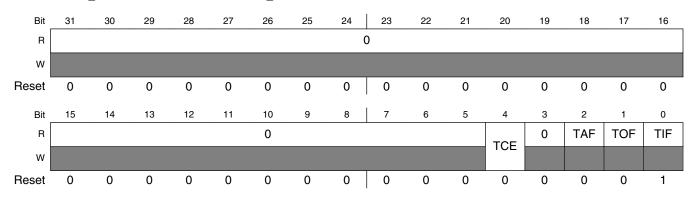
Register definition

RTC_CR field descriptions (continued)

Field	Description		
	0 Wakeup pin is disabled.		
	1 Wakeup pin is enabled and wakeup pin asserts if the RTC interrupt asserts or the wakeup pin is turned on.		
0 SWR	Software Reset		
	0 No effect.		
	1 Resets all RTC registers except for the SWR bit and the RTC_WAR and RTC_RAR registers . The SWR bit is cleared by POR and by software explicitly clearing it.		

43.3.6 RTC Status Register (RTC_SR)





RTC_SR field descriptions

Field	Description
31–5 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
4 TCE	Time Counter Enable When time counter is disabled the TSR register and TPR register are writeable, but do not increment. When time counter is enabled the TSR register and TPR register are not writeable, but increment. Time counter is disabled. Time counter is enabled.
3 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
2 TAF	Time Alarm Flag Time alarm flag is set when the TAR[TAR] equals the TSR[TSR] and the TSR[TSR] increments. This bit is cleared by writing the TAR register. 0 Time alarm has not occurred. 1 Time alarm has occurred.
1 TOF	Time Overflow Flag

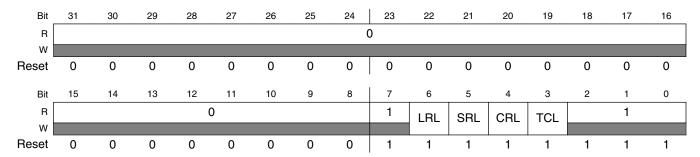
Table continues on the next page...

RTC_SR field descriptions (continued)

Field	Description
	Time overflow flag is set when the time counter is enabled and overflows. The TSR and TPR do not increment and read as zero when this bit is set. This bit is cleared by writing the TSR register when the time counter is disabled.
	0 Time overflow has not occurred.
	1 Time overflow has occurred and time counter is read as zero.
0 TIF	Time Invalid Flag
I IIF	The time invalid flag is set on POR or software reset. The TSR and TPR do not increment and read as zero when this bit is set. This bit is cleared by writing the TSR register when the time counter is disabled.
	0 Time is valid.
	1 Time is invalid and time counter is read as zero.

43.3.7 RTC Lock Register (RTC_LR)

Address: 4003_D000h base + 18h offset = 4003_D018h



RTC_LR field descriptions

Field	Description
31–8 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
7 Reserved	This field is reserved. This read-only field is reserved and always has the value 1.
6 LRL	Lock Register Lock After being cleared, this bit can be set only by POR or software reset. Under Company Com
5 SRL	Status Register Lock After being cleared, this bit can be set only by POR or software reset. O Status Register is locked and writes are ignored. Status Register is not locked and writes complete as normal.
4 CRL	Control Register Lock

Table continues on the next page...

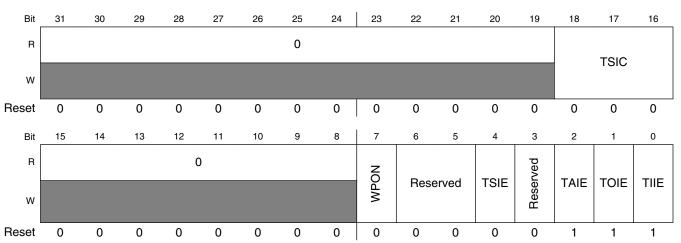
Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

RTC_LR field descriptions (continued)

Field	Description
	After being cleared, this bit can only be set by POR.
	0 Control Register is locked and writes are ignored.
	1 Control Register is not locked and writes complete as normal.
3 TCL	Time Compensation Lock
IOL	After being cleared, this bit can be set only by POR or software reset.
	0 Time Compensation Register is locked and writes are ignored.
	1 Time Compensation Register is not locked and writes complete as normal.
Reserved	This field is reserved. This read-only field is reserved and always has the value 1.

43.3.8 RTC Interrupt Enable Register (RTC_IER)

Address: 4003_D000h base + 1Ch offset = 4003_D01Ch



RTC_IER field descriptions

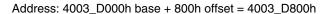
Field	Description
31–19	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
18–16 TSIC	Timer Seconds Interrupt Configuration
	Configures the frequency of the RTC Seconds interrupt and the RTC_CLKOUT prescaler output. This field should only be altered when TSIE is clear.
	000 1 Hz.
	001 2 Hz.
	010 4 Hz.
	011 8 Hz.
	100 16 Hz.
	101 32 Hz.

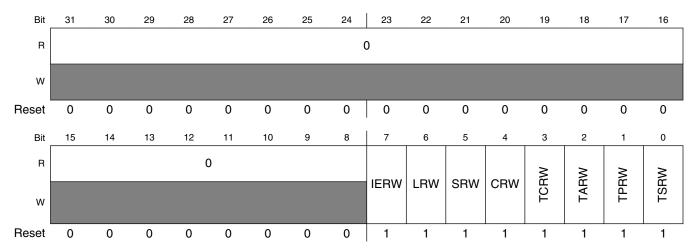
Table continues on the next page...

RTC_IER field descriptions (continued)

Field	Description
	110 64 Hz. 111 128 Hz.
15–8 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
7 WPON	Wakeup Pin On The wakeup pin is optional and not available on all devices. Whenever the wakeup pin is enabled and this
	bit is set, the wakeup pin will assert. O No effect.
6–5 Reserved	If the wakeup pin is enabled, then the wakeup pin will assert. This field is reserved.
4 TSIE	Time Seconds Interrupt Enable The seconds interrupt is an edge-sensitive interrupt with a dedicated interrupt vector. It is generated once a second and requires no software overhead (there is no corresponding status flag to clear).
	0 Seconds interrupt is disabled.1 Seconds interrupt is enabled.
3 Reserved	This field is reserved.
2 TAIE	Time Alarm Interrupt Enable
	Time alarm flag does not generate an interrupt.Time alarm flag does generate an interrupt.
1 TOIE	Time Overflow Interrupt Enable
	Time overflow flag does not generate an interrupt.Time overflow flag does generate an interrupt.
0 TIIE	Time Invalid Interrupt Enable
11112	Time invalid flag does not generate an interrupt.Time invalid flag does generate an interrupt.

43.3.9 RTC Write Access Register (RTC_WAR)





RTC_WAR field descriptions

Field	Description
31–8	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
7 IERW	Interrupt Enable Register Write
	After being cleared, this bit is set only by system reset. It is not affected by software reset.
	0 Writes to the Interupt Enable Register are ignored.
	1 Writes to the Interrupt Enable Register complete as normal.
6 LRW	Lock Register Write
	After being cleared, this bit is set only by system reset. It is not affected by software reset.
	0 Writes to the Lock Register are ignored.
	1 Writes to the Lock Register complete as normal.
5 SRW	Status Register Write
	After being cleared, this bit is set only by system reset. It is not affected by software reset.
	0 Writes to the Status Register are ignored.
	1 Writes to the Status Register complete as normal.
4 CRW	Control Register Write
	After being cleared, this bit is set only by system reset. It is not affected by software reset.
	0 Writes to the Control Register are ignored.
	1 Writes to the Control Register complete as normal.
3 TCRW	Time Compensation Register Write
	After being cleared, this bit is set only by system reset. It is not affected by software reset.

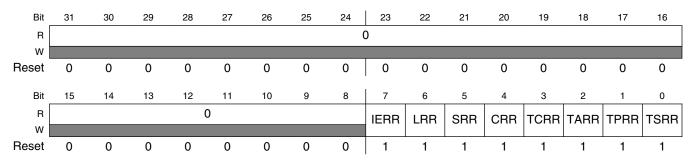
Table continues on the next page...

RTC_WAR field descriptions (continued)

Field	Description
	0 Writes to the Time Compensation Register are ignored.
	1 Writes to the Time Compensation Register complete as normal.
2 TARW	Time Alarm Register Write
	After being cleared, this bit is set only by system reset. It is not affected by software reset.
	0 Writes to the Time Alarm Register are ignored.
	1 Writes to the Time Alarm Register complete as normal.
1 TPRW	Time Prescaler Register Write
	After being cleared, this bit is set only by system reset. It is not affected by software reset.
	0 Writes to the Time Prescaler Register are ignored.
	1 Writes to the Time Prescaler Register complete as normal.
0 TSRW	Time Seconds Register Write
	After being cleared, this bit is set only by system reset. It is not affected by software reset.
	0 Writes to the Time Seconds Register are ignored.
	1 Writes to the Time Seconds Register complete as normal.

43.3.10 RTC Read Access Register (RTC_RAR)

Address: 4003_D000h base + 804h offset = 4003_D804h



RTC_RAR field descriptions

Field	Description
31–8 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
7 IERR	Interrupt Enable Register Read After being cleared, this bit is set only by system reset. It is not affected by software reset. O Reads to the Interrupt Enable Register are ignored. Reads to the Interrupt Enable Register complete as normal.
6 LRR	Lock Register Read

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Functional description

RTC_RAR field descriptions (continued)

Field	Description
	After being cleared, this bit is set only by system reset. It is not affected by software reset.
	0 Reads to the Lock Register are ignored.
	1 Reads to the Lock Register complete as normal.
5	Status Register Read
SRR	After being cleared, this bit is set only by system reset. It is not affected by software reset.
	0 Reads to the Status Register are ignored.
	1 Reads to the Status Register complete as normal.
4	Control Register Read
CRR	After being cleared, this bit is set only by system reset. It is not affected by software reset.
	0 Reads to the Control Register are ignored.
	1 Reads to the Control Register complete as normal.
3 TCRR	Time Compensation Register Read
ICHH	After being cleared, this bit is set only by system reset. It is not affected by software reset.
	0 Reads to the Time Compensation Register are ignored.
	1 Reads to the Time Compensation Register complete as normal.
2 TARR	Time Alarm Register Read
	After being cleared, this bit is set only by system reset. It is not affected by software reset.
	0 Reads to the Time Alarm Register are ignored.
	1 Reads to the Time Alarm Register complete as normal.
1 TPRR	Time Prescaler Register Read
111111	After being cleared, this bit is set only by system reset. It is not affected by software reset.
	0 Reads to the Time Pprescaler Register are ignored.
	1 Reads to the Time Prescaler Register complete as normal.
0 TSRR	Time Seconds Register Read
. 3	After being cleared, this bit is set only by system reset. It is not affected by software reset.
	0 Reads to the Time Seconds Register are ignored.
	1 Reads to the Time Seconds Register complete as normal.

43.4 Functional description

43.4.1 Power, clocking, and reset

The RTC is an always powered block that remains active in all low power modes.

The time counter within the RTC is clocked by a 32.768 kHz clock sourced from an external crystal using the oscillator. Alternatively, the time counter can be clocked by the LPO and the prescaler will increment by 32 for each LPO clock.

The power-on-reset signal initializes all RTC registers to their default state. A software reset bit can also initialize all RTC registers.

43.4.1.1 Oscillator control

The 32.768 kHz crystal oscillator is disabled at POR and must be enabled by software. After enabling the cystal oscillator, wait the oscillator startup time before setting SR[TCE] or using the oscillator clock external to the RTC.

43.4.1.2 Software reset

Writing 1 to CR[SWR] forces the equivalent of a POR to the rest of the RTC module. CR[SWR] is not affected by the software reset and must be cleared by software. The access control registers are not affected by either VBAT POR or the software reset; they are reset by the chip reset.

Supervisor access 43.4.1.3

When the supervisor access control bit is clear, only supervisor mode software can write to the RTC registers, non-supervisor mode software will generate a bus error. Both supervisor and non-supervisor mode software can always read the RTC registers.

43.4.2 Time counter

The time counter consists of a 32-bit seconds counter that increments once every second and a 16-bit prescaler register that increments once every 32.768 kHz clock cycle. There is also the option to clock the prescaler using a 1 kHz LPO that increments the prescaler by 32 on every clock cycle.

Reading the time counter (either seconds or prescaler) while it is incrementing may return invalid data due to synchronization of the read data bus. If it is necessary for software to read the prescaler or seconds counter when they could be incrementing, it is recommended that two read accesses are performed and that software verifies that the same data was returned for both reads.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018 **NXP Semiconductors** 1083

Functional description

The time seconds register and time prescaler register can be written only when SR[TCE] is clear. Always write to the prescaler register before writing to the seconds register, because the seconds register increments on the falling edge of bit 14 of the prescaler register.

The time prescaler register increments provided SR[TCE] is set, SR[TIF] is clear, SR[TOF] is clear, and the 32.768 kHz (or 1 kHz) clock source is present. After enabling the oscillator, wait the oscillator startup time before setting SR[TCE] to allow time for the oscillator clock output to stabilize.

If the time seconds register overflows then the SR[TOF] will set and the time prescaler register will stop incrementing. Clear SR[TOF] by initializing the time seconds register. The time seconds register and time prescaler register read as zero whenever SR[TOF] is set.

SR[TIF] is set on POR and software reset and is cleared by initializing the time seconds register. The time seconds register and time prescaler register read as zero whenever SR[TIF] is set.

43.4.3 Compensation

The compensation logic provides an accurate and wide compensation range and can correct errors as high as 3906 ppm and as low as 0.12 ppm. The compensation factor must be calculated externally to the RTC and supplied by software to the compensation register. The RTC itself does not calculate the amount of compensation that is required, although the 1 Hz clock is output to an external pin in support of external calibration logic.

Crystal compensation can be supported by using firmware and crystal characteristics to determine the compensation amount. Temperature compensation can be supported by firmware that periodically measures the external temperature via ADC and updates the compensation register based on a look-up table that specifies the change in crystal frequency over temperature.

The compensation logic alters the number of 32.768 kHz clock cycles it takes for the prescaler register to overflow and increment the time seconds counter. The time compensation value is used to adjust the number of clock cycles between -127 and +128. Cycles are added or subtracted from the prescaler register when the prescaler register equals 0x3FFF and then increments. The compensation interval is used to adjust the frequency at which the time compensation value is used, that is, from once a second to once every 256 seconds.

Updates to the time compensation register will not take effect until the next time the time seconds register increments and provided the previous compensation interval has expired. When the compensation interval is set to other than once a second then the compensation is applied in the first second interval and the remaining second intervals receive no compensation.

Compensation is disabled by configuring the time compensation register to zero.

When the prescaler is configured to increment using the 1 kHz LPO, the effective compensation value is divided by 32 and can only adjust the number of clock cycles between -4 and +3.

43.4.4 Time alarm

The Time Alarm register (TAR), SR[TAF], and IER[TAIE] allow the RTC to generate an interrupt at a predefined time. The 32-bit TAR is compared with the 32-bit Time Seconds register (TSR) each time it increments. SR[TAF] will set when TAR equals TSR and TSR increments.

SR[TAF] is cleared by writing TAR. This will usually be the next alarm value, although writing a value that is less than TSR, such as 0, will prevent SR[TAF] from setting again. SR[TAF] cannot otherwise be disabled, although the interrupt it generates is enabled or disabled by IER[TAIE].

43.4.5 Update mode

The Update Mode field in the Control register (CR[UM]) configures software write access to the Time Counter Enable (SR[TCE]) field. When CR[UM] is clear, SR[TCE] can be written only when LR[SRL] is set. When CR[UM] is set, SR[TCE] can also be written when SR[TCE] is clear or when SR[TIF] or SR[TOF] are set. This allows the time seconds and prescaler registers to be initialized whenever time is invalidated, while preventing the time seconds and prescaler registers from being changed on the fly. When LR[SRL] is set, CR[UM] has no effect on SR[TCE].

43.4.6 Register lock

The Lock register (LR) can be used to block write accesses to certain registers until the next POR or software reset. Locking the Control register (CR) will disable the software reset. Locking LR will block future updates to LR.

Usage Guide

Write accesses to a locked register are ignored and do not generate a bus error.

43.4.7 Access control

The read access and write access registers are implemented in the chip power domain and reset on the chip reset. They are not affected by the POR or the software reset. They are used to block read or write accesses to each register until the next chip system reset.

43.4.8 Interrupt

The RTC interrupt is asserted whenever a status flag and the corresponding interrupt enable bit are both set. It is always asserted on POR, and software reset. The RTC interrupt is enabled at the chip level by enabling the chip-specific RTC clock gate control bit. The RTC interrupt can be used to wakeup the chip from any low-power mode.

The optional RTC seconds interrupt is an edge-sensitive interrupt with a dedicated interrupt vector that is generated once a second and requires no software overhead (there is no corresponding status flag to clear). It is enabled in the RTC by the time seconds interrupt enable bit and enabled at the chip level by setting the chip-specific RTC clock gate control bit. The frequency of the seconds interrupt defaults to 1 Hz, but can instead be configured to trigger every 2, 4, 8, 16, 32, 64 or 128 Hz. This interrupt is optional and may not be implemented on all devices.

43.5 Usage Guide

43.5.1 Clock source information

To get an accuracy clock for RTC, an external 32.768 kHz crystal should be connected to EXTAL32/XTAL32 pin, or a 32.768 kHz clock signal to RTC_CLKIN pin. Alternatively, the time counter can be clocked by the LPO 1 kHz and the prescaler will increment by 32 for each LPO clock, which is not that precisely.

43.5.2 Usage examples

This section shows the application examples of initializing the RTC module, setting the data time and alarm.

RTC Module Initialization

The RTC module is reset by a POR or a software reset (The access control registers are not affected by either VBAT POR or the software reset).

Before using the RTC module, a software reset is recommend by setting the RTC_CR[SWR] bit. And the 32.768 kHz external crystal should be enabled to provide clock to RTC.

Set Date Time

After RTC initialized, user can set the date time before starting the timer. Please make sure the timer is stopped when setting the date time by RTC_TSR register.

```
// stop timer first
RTC_SR &= ~RTC_SR_TCE_MASK;
// convert the date time to secs first, then write to RTC_TSR register
RTC_TSR = datetime_in_secs;
// start the timer
RTC_SR |= RTC_SR_TCE_MASK;
```

Set Alarm

To set an alarm and trigger alarm interrupt, user should enable the alarm interrupt, write the alarm seconds into RTC_TAR.

```
uint32_t datetime_in_secs;
// assume the timer is running
// enable the interrupt
RTC_IER |= RTC_IER_TAIE_MASK;
// enable the RTC IRQ in NVIC
NVIC_EnableIRQ(RTC_IRQn);
// get the current date time in secs
datetime_in_secs = RTC_TSR;
datatime_in_secs += 10;
// set alarm 10s later
RTC TAR = datetime in secs;
```

After 10 seconds, the RTC Alarm IRQ would be triggered and IRQ Handler called. In the IRQ Handler, user should first clear the interrupt status:

Usage Guide

```
if (RTC_SR & RTC_SR_TAF_MASK)
{
    // clear the TAF flag by writing the RTC_TAR register
    RTC_TAR = 0;
}
// Then doing the alarm task in this IRQ Handler
```

43.5.3 RTC_CLKOUT signal

When the RTC is enabled and the port control module selects the RTC_CLKOUT function, the RTC_CLKOUT signal output either a square wave prescaler output (configurable to 1, 2, 4, 8, 16, 32, 64 or 128 Hz) or 32 kHz output derived from RTC oscillator as shown below.

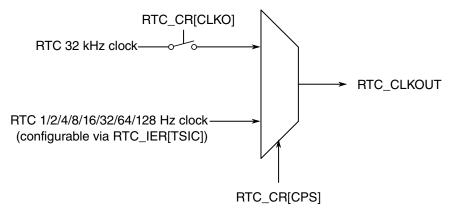


Figure 43-1. RTC_CLKOUT generation

NOTE

When using LPO 1kHz as RTC clock source, it cannot directly output to pad. But RTC can normally output 1/2/4/8/.../64/128 Hz clock using prescaler.

Chapter 44 Low Power Serial Peripheral Interface (LPSPI)

44.1 Chip-specific information for this module

44.1.1 Instantiation Information

This device contains two LPSPI modules. The LPSPI can remain functional in Stop and VLPS mode provided the clock it is using remains enabled.

Table 44-1. LPSPI Configuration

	TX FIFO (word/32bit)	RX FIFO (word/32bit)	Chip Selects
LPSPI0	4	4	4
LPSPI1	4	4	4

NOTE

The TX/RX FIFO "word" does not refer to system bus width 32-bit, and it varies for different communication module. For example:

• LPSPI: 32-bit

• LPI2C: 8-bit (except CMD)

• LPUART: 10-bit

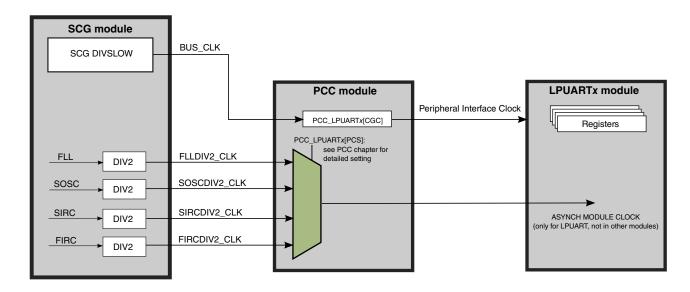
NOTE

The exact number of chip select for each module is depending on the package, not all of the chip selects are available on different packages.

44.1.2 Module Clocking Information for LPUART, LPSPI, LPI2C, FlexIO and LPIT

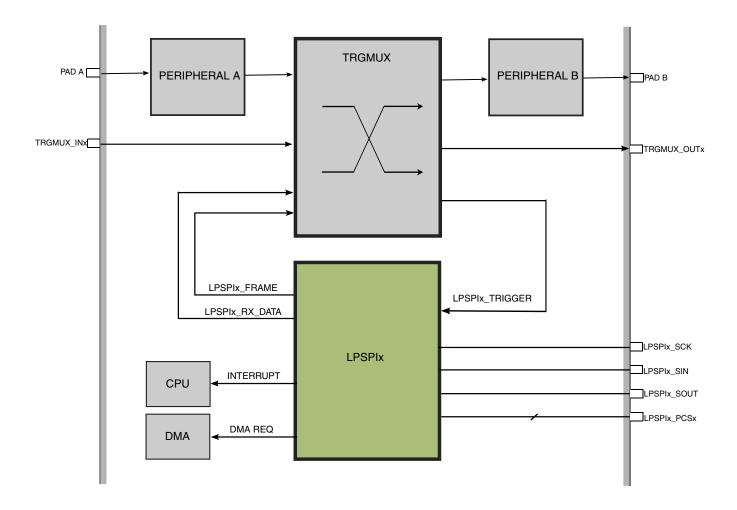
The following figure shows the input clock sources available for this module.

Peripheral Clocking - LPUART Note: this example figure also applies similarly to the clocking for LPSPI, LPI2C, and LPIT.



44.1.3 Inter-connectivity Information

The LPSPI inter-connectivity is shown in following diagram.



44.2 Introduction

44.2.1 Overview

The LPSPI is a low power Serial Peripheral Interface (SPI) module that supports an efficient interface to an SPI bus as a master and/or a slave. The LPSPI can continue operating in stop modes provided an appropriate clock is available and is designed for low CPU overhead with DMA offloading of FIFO register accesses.

44.2.2 Features

The LPSPI supports the following features:

Introduction

- Word size = 32 bits
- Command/transmit FIFO of 4 words.
- Receive FIFO of 4 words.
- Host request input can be used to control the start time of an SPI bus transfer.

44.2.3 Block Diagram

LPSPI block diagram

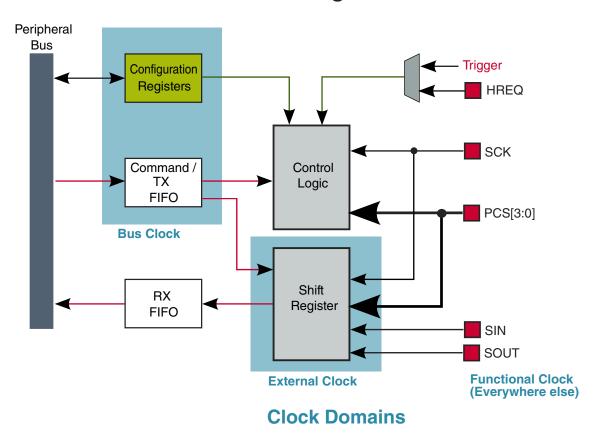


Figure 44-1. Block Diagram

44.2.4 Modes of operation

The LPSPI module supports the chip modes described in the following table.

Table 44-2. Chip modes supported by the LPSPI module

Chip mode	LPSPI Operation
Run	Normal operation

Table continues on the next page...

Table 44-2. Chip modes supported by the LPSPI module (continued)

Chip mode	LPSPI Operation
	Can continue operating if the Doze Enable bit (MCR[DOZEN]) is set and the LPSPI is using an external or internal clock source, which remains operating during stop/wait modes.
Debug	Can continue operating if the Debug Enable bit (MCR[DBGE]) is set.

44.2.5 Signal Descriptions

Signal	Description	I/O
SCK	Serial clock. Input in slave mode, output in master mode.	I/O
PCS[0]	Peripheral Chip Select. Input in slave mode, output in master mode.	I/O
PCS[1] / HREQ	Peripheral Chip Select or Host Request. Host Request pin is selected when HREN=1 and HRSEL=0. Input in either slave mode or when used as Host Request, output in master mode.	I/O
PCS[2] / DATA[2]	Peripheral Chip Select or data pin 2 during quad-data transfers. Input in slave mode, output in master mode, input in quad-data receive transfers, output in quad-data transmit transfers.	I/O
PCS[3] / DATA[3]	Peripheral Chip Select or data pin 3 during quad-data transfers. Input in slave mode, output in master mode, input in quad-data receive transfers, output in quad-data transmit transfers.	I/O
SOUT / DATA[0]	Serial Data Output. Can be configured as serial data input signal. Used as data pin 0 in quad-data and dual-data transfers.	I/O
SIN / DATA[1]	Serial Data Input. Can be configured as serial data output signal. Used as data pin 1 in quad-data and dual-data transfers.	I/O

44.3 Memory Map and Registers

LPSPI memory map

Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page
4002_C000	Version ID Register (LPSPI0_VERID)	32	R	0100_0004h	44.3.1/1095
4002_C004	Parameter Register (LPSPI0_PARAM)	32	R	See section	44.3.2/1096
4002_C010	Control Register (LPSPI0_CR)	32	R/W	0000_0000h	44.3.3/1097
4002_C014	Status Register (LPSPI0_SR)	32	R/W	0000_0001h	44.3.4/1098
4002_C018	Interrupt Enable Register (LPSPI0_IER)	32	R/W	0000_0000h	44.3.5/1100
4002_C01C	DMA Enable Register (LPSPI0_DER)	32	R/W	0000_0000h	44.3.6/1101
4002_C020	Configuration Register 0 (LPSPI0_CFGR0)	32	R/W	0000_0000h	44.3.7/1102
4002_C024	Configuration Register 1 (LPSPI0_CFGR1)	32	R/W	0000_0000h	44.3.8/1103
4002_C030	Data Match Register 0 (LPSPI0_DMR0)	32	R/W	0000_0000h	44.3.9/1105
4002_C034	Data Match Register 1 (LPSPI0_DMR1)	32	R/W	0000_0000h	44.3.10/ 1105
4002_C040	Clock Configuration Register (LPSPI0_CCR)	32	R/W	0000_0000h	44.3.11/ 1106
4002_C058	FIFO Control Register (LPSPI0_FCR)	32	R/W	0000_0000h	44.3.12/ 1107
4002_C05C	FIFO Status Register (LPSPI0_FSR)	32	R	0000_0000h	44.3.13/ 1107
4002_C060	Transmit Command Register (LPSPI0_TCR)	32	R/W	0000_001Fh	44.3.14/ 1108
4002_C064	Transmit Data Register (LPSPI0_TDR)	32	W	0000_0000h	44.3.15/ 1111
4002_C070	Receive Status Register (LPSPI0_RSR)	32	R	0000_0002h	44.3.16/ 1112
4002_C074	Receive Data Register (LPSPI0_RDR)	32	R	0000_0000h	44.3.17/ 1113
4002_D000	Version ID Register (LPSPI1_VERID)	32	R	0100_0004h	44.3.1/1095
4002_D004	Parameter Register (LPSPI1_PARAM)	32	R	See section	44.3.2/1096
4002_D010	Control Register (LPSPI1_CR)	32	R/W	0000_0000h	44.3.3/1097
4002_D014	Status Register (LPSPI1_SR)	32	R/W	0000_0001h	44.3.4/1098
4002_D018	Interrupt Enable Register (LPSPI1_IER)	32	R/W	0000_0000h	44.3.5/1100
4002_D01C	DMA Enable Register (LPSPI1_DER)	32	R/W	0000_0000h	44.3.6/1101
4002_D020	Configuration Register 0 (LPSPI1_CFGR0)	32	R/W	0000_0000h	44.3.7/1102
4002_D024	Configuration Register 1 (LPSPI1_CFGR1)	32	R/W	0000_0000h	44.3.8/1103
4002_D030	Data Match Register 0 (LPSPI1_DMR0)	32	R/W	0000_0000h	44.3.9/1105
4002_D034	Data Match Register 1 (LPSPI1_DMR1)	32	R/W	0000_0000h	44.3.10/ 1105

Table continues on the next page...

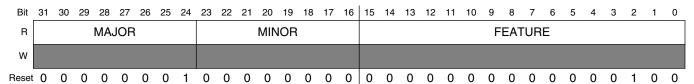
Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

LPSPI memory map (continued)

Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page
4002_D040	Clock Configuration Register (LPSPI1_CCR)	32	R/W	0000_0000h	44.3.11/ 1106
4002_D058	FIFO Control Register (LPSPI1_FCR)	32	R/W	0000_0000h	44.3.12/ 1107
4002_D05C	FIFO Status Register (LPSPI1_FSR)	32	R	0000_0000h	44.3.13/ 1107
4002_D060	Transmit Command Register (LPSPI1_TCR)	32	R/W	0000_001Fh	44.3.14/ 1108
4002_D064	Transmit Data Register (LPSPI1_TDR)	32	W	0000_0000h	44.3.15/ 1111
4002_D070	Receive Status Register (LPSPI1_RSR)	32	R	0000_0002h	44.3.16/ 1112
4002_D074	Receive Data Register (LPSPI1_RDR)	32	R	0000_0000h	44.3.17/ 1113

44.3.1 Version ID Register (LPSPIx_VERID)

Address: Base address + 0h offset



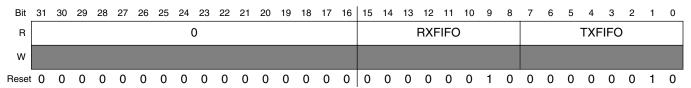
LPSPIx_VERID field descriptions

Field	Description
31–24 MAJOR	Major Version Number
	This read only field returns the major version number for the module specification.
23–16 MINOR	Minor Version Number
	This read only field returns the minor version number for the module specification.
FEATURE	Module Identification Number
	This read only field returns the feature set number.
	0x0004 Standard feature set supporting 32-bit shift register.

44.3.2 Parameter Register (LPSPIx_PARAM)

•

Address: Base address + 4h offset

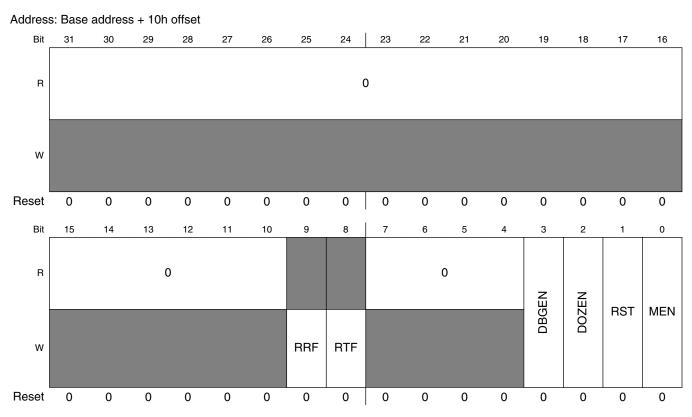


LPSPIx_PARAM field descriptions

Field	Description
31–16 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
15–8 RXFIFO	Receive FIFO Size The number of words in the receive FIFO is 2^RXFIFO.
TXFIFO	Transmit FIFO Size The number of words in the transmit FIFO is 2^TXFIFO.

LIVE O

44.3.3 Control Register (LPSPIx_CR)



LPSPIx_CR field descriptions

Field	Description
31–10 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
9 RRF	Reset Receive FIFO
	0 No effect.
	1 Receive FIFO is reset.
8 RTF	Reset Transmit FIFO
	0 No effect.
	1 Transmit FIFO is reset.
7–4	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
3 DBGEN	Debug Enable
	0 Module is disabled in debug mode.
	1 Module is enabled in debug mode.
2 DOZEN	Doze mode enable
	Enables or disables Doze mode

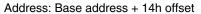
Table continues on the next page...

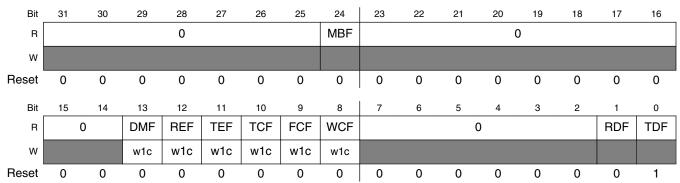
Memory Map and Registers

LPSPIx_CR field descriptions (continued)

Field	Description
	0 Module is enabled in Doze mode.
	1 Module is disabled in Doze mode.
1	Software Reset
RST	Reset all internal logic and registers, except the Control Register. Remains set until cleared by software. O Master logic is not reset.
_	1 Master logic is reset.
0 MEN	Module Enable
	0 Module is disabled.
	1 Module is enabled.

44.3.4 Status Register (LPSPIx_SR)





LPSPIx_SR field descriptions

Field	Description
31–25 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
24 MBF	Module Busy Flag 0 LPSPI is idle. 1 LPSPI is busy.
23–14 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
13 DMF	Data Match Flag Indicates that the received data has matched the MATCH0 and/or MATCH1 fields as configured by MATCFG. O Have not received matching data. Have received matching data.

Table continues on the next page...

LPSPIx_SR field descriptions (continued)

Field	Description
12	Receive Error Flag
REF	TI. (1 . III . I . I . I . I . I . I . I . I
	This flag will set when the Receiver FIFO overflows.
	0 Receive FIFO has not overflowed.
	1 Receive FIFO has overflowed.
11	Transmit Error Flag
TEF	This flag will set when the Transmit FIFO underruns.
	0 Transmit FIFO underrun has not occurred.
	1 Transmit FIFO underrun has not occurred
10	Transfer Complete Flag
TCF	Transfer Complete Flag
	This flag will set in master mode when the LPSPI returns to idle state with the transmit FIFO empty.
	0 All transfers have not completed.
	1 All transfers have completed.
9	Frame Complete Flag
FCF	This flag will set at the end of each frame transfer, when the PCS negates.
	O. Frame transfer has not completed
	Frame transfer has not completed.Frame transfer has completed.
8	Word Complete Flag
WCF	Word Complete Flag
	This flag will set when the last bit of a received word is sampled.
	0 Transfer word not completed.
	1 Transfer word completed.
7–2	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
1 RDF	Receive Data Flag
NDF	The Receive Data Flag is set whenever the number of words in the receive FIFO is greater than
	RXWATER.
	0 Receive Data is not ready.
	1 Receive data is ready.
0	Transmit Data Flag
TDF	The Transmit Data Flag is set whenever the number of words in the transmit FIFO is equal or less than
	TXWATER.
	0 Transmit data not requested.
	1 Transmit data is requested.

0

0

0

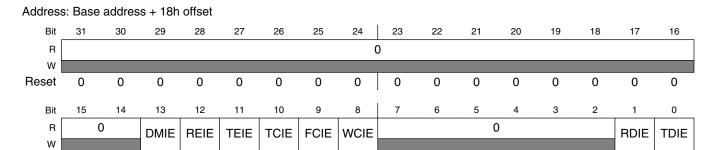
0

0

0

Reset

44.3.5 Interrupt Enable Register (LPSPIx_IER)



LPSPIx_IER field descriptions

0

0

0

0

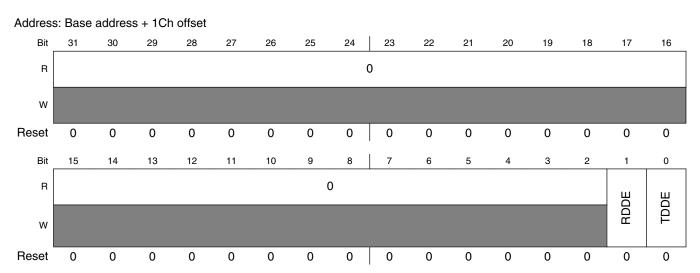
Field	Description
31–14 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
13 DMIE	Data Match Interrupt Enable 0 Interrupt disabled. 1 Interrupt enabled.
12 REIE	Receive Error Interrupt Enable O Interrupt disabled. Interrupt enabled.
11 TEIE	Transmit Error Interrupt Enable 0 Interrupt disabled. 1 Interrupt enabled.
10 TCIE	Transfer Complete Interrupt Enable 0 Interrupt disabled. 1 Interrupt enabled.
9 FCIE	Frame Complete Interrupt Enable 0 Interrupt disabled. 1 Interrupt enabled.
8 WCIE	Word Complete Interrupt Enable 0 Interrupt disabled. 1 Interrupt enabled.
7–2 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
1 RDIE	Receive Data Interrupt Enable 0 Interrupt disabled. 1 Interrupt enabled.
0 TDIE	Transmit Data Interrupt Enable

Table continues on the next page...

LPSPIx_IER field descriptions (continued)

Field	Description
	0 Interrupt disabled.
	1 Interrupt enabled

DMA Enable Register (LPSPIx_DER) 44.3.6

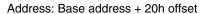


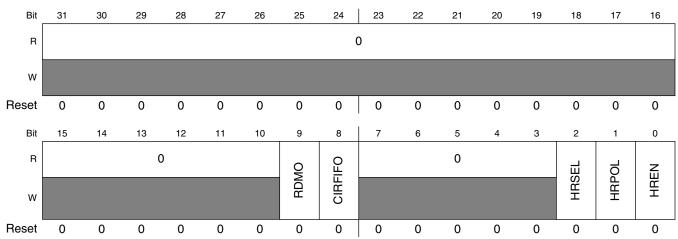
LPSPIx_DER field descriptions

Field	Description
31–2 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
1 RDDE	Receive Data DMA Enable
NDDE	DMA request disabled. DMA request enabled.
0 TDDE	Transmit Data DMA Enable
	DMA request disabled. DMA request enabled

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018 1101 **NXP Semiconductors**

44.3.7 Configuration Register 0 (LPSPIx_CFGR0)





LPSPIx_CFGR0 field descriptions

Field	Description
31–10 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
9 RDMO	Receive Data Match Only When enabled, all received data that does not cause DMF to set is discarded. Once DMF is set, the RDMO configuration is ignored. When disabling RDMO, clear RDMO before clearing DMF to ensure no receive data is lost. O Received data is stored in the receive FIFO as normal. Received data is discarded unless the DMF is set.
8 CIRFIFO	Circular FIFO Enable When enabled, the transmit FIFO read pointer is saved to a temporary register. The transmit FIFO will be emptied as normal, but once the LPSPI is idle and the transmit FIFO is empty, then the read pointer value will be restored from the temporary register. This will cause the contents of the transmit FIFO to be cycled through repeatedly. O Circular FIFO is disabled. Circular FIFO is enabled.
7–3 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
2 HRSEL	Host Request Select Selects the source of the host request input. When the host request function is enabled with the LPSPI_HREQ pin, the LPSPI_PCS[1] function is disabled. 0 Host request input is pin LPSPI_HREQ. 1 Host request input is input trigger.
1 HRPOL	Host Request Polarity

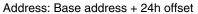
Table continues on the next page...

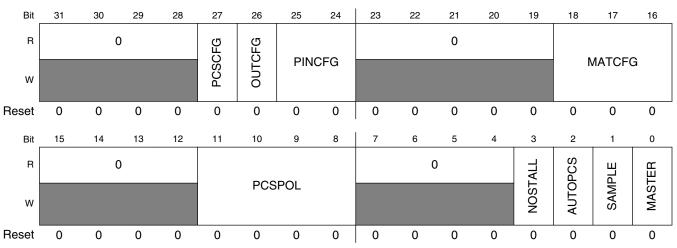
LPSPIx_CFGR0 field descriptions (continued)

Field	Description
	Configures the polarity of the host request pin.
	0 Active low.
	1 Active high.
0 HREN	Host Request Enable
	When enabled in master mode, the LPSPI will only initiate a SPI bus transfer if the host request input is asserted.
	0 Host request is disabled.
	1 Host request is enabled.

44.3.8 Configuration Register 1 (LPSPIx_CFGR1)

The CFGR1 should only be written when the LPSPI is disabled.





LPSPIx_CFGR1 field descriptions

Field	Description
31–28 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
27 PCSCFG	Peripheral Chip Select Configuration PCSCFG must be set if performing 4-bit transfers.
	0 PCS[3:2] are enabled.1 PCS[3:2] are disabled.
26 OUTCFG	Output Config Configures if the output data is tristated between accesses (LPSPI_PCS is negated).

Table continues on the next page...

Memory Map and Registers

LPSPIx_CFGR1 field descriptions (continued)

Field	Description
	Output data retains last value when chip select is negated.
	1 Output data is tristated when chip select is negated.
25–24 PINCFG	Pin Configuration
	Configures which pins are used for input and output data during single bit transfers.
	00 SIN is used for input data and SOUT for output data.
	01 SIN is used for both input and output data.
	10 SOUT is used for both input and output data.
	11 SOUT is used for input data and SIN for output data.
23–19 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
18–16 MATCFG	Match Configuration
	Configures the condition that will cause the DMF to set.
	000 Match disabled.
	001 Reserved
	010 Match enabled (1st data word equals MATCH) OR MATCH).
	011 Match enabled (any data word equals MATCH) OR MATCH).
	 Match enabled (1st data word equals MATCH0 AND 2nd data word equals MATCH1). Match enabled (any data word equals MATCH0 AND next data word equals MATCH1)
	110 Match enabled (1st data word AND MATCH1 equals MATCH1)
	111 Match enabled (any data word AND MATCH1 equals MATCH0 AND MATCH1).
15–12	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
11–8 PCSPOL	Peripheral Chip Select Polarity
1 001 02	Configures the polarity of each Peripheral Chip Select pin.
	0 The PCSx is active low.
	1 The PCSx is active high.
7–4 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
3	No Stall
NOSTALL	No otali
	In master mode, the LPSPI will stall transfers when the transmit FIFO is empty or receive FIFO is full ensuring that no transmit FIFO underrun or receive FIFO overrun can occur. Setting this bit will disable this functionality.
	0 Transfers will stall when transmit FIFO is empty or receive FIFO is full.
	1 Transfers will not stall, allowing transmit FIFO underrun or receive FIFO overrun to occur.
2 AUTOPCS	Automatic PCS
	The LPSPI slave normally requires the PCS to negate between frames for correct operation. Setting this bit will cause the LPSPI to generate an internal PCS signal at the end of each transfer word when CPHA=1. When this bit is set, the SCK must remain idle for at least 4 LPSPI functional clock cycles (divided by PRESCALE configuration) between each word to ensure correct operation. This bit is ignored in master mode.

Table continues on the next page...

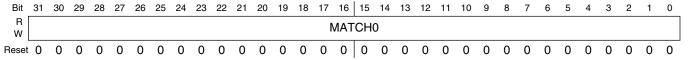
Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

LPSPIx_CFGR1 field descriptions (continued)

Field	Description
	0 Automatic PCS generation disabled.
	1 Automatic PCS generation enabled.
1 SAMPLE	Sample Point
O/WII EE	When set, the LPSPI master will sample the input data on a delayed LPSPI_SCK edge. This improves the setup time when sampling data. The input data setup time in master mode with delayed LPSPI_SCK edge is equal to the input data setup time in slave mode. This bit is ignored in slave mode.
	0 Input data sampled on SCK edge.
	1 Input data sampled on delayed SCK edge.
0 MASTER	Master Mode
	Configures the LPSPI in master or slave mode. This bit directly controls the direction of the LPSPI_SCK and LPCPI_PCS pins.
	0 Slave mode.
	1 Master mode.

44.3.9 Data Match Register 0 (LPSPIx_DMR0)

Address: Base address + 30h offset

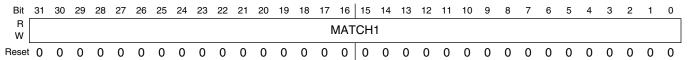


LPSPIx_DMR0 field descriptions

Field	Description
MATCH0	Match 0 Value
	Compared against the received data when receive data match is enabled.

44.3.10 Data Match Register 1 (LPSPIx_DMR1)

Address: Base address + 34h offset



LPSPIx_DMR1 field descriptions

Field	Description
MATCH1	Match 1 Value

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Memory Map and Registers

LPSPIx_DMR1 field descriptions (continued)

Field	Description				
Compared against the received data when receive data match is enabled.					

44.3.11 Clock Configuration Register (LPSPIx_CCR)

The CCR is only used in master mode and cannot be changed when the LPSPI is enabled.

Address: Base address + 40h offset

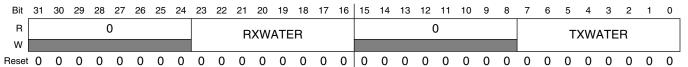
Bit	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
R				SCK	DC	2						200	SC1	,						DE	ot							SCK	עום	,		
W				SUN	FU	3					Г	-03	SCr	`						וט)						•	SUN	עוט			
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

LPSPIx_CCR field descriptions

Field	Description
31–24 SCKPCS	SCK to PCS Delay Configures the delay in master mode from the last SCK edge to the PCS negation. The delay is equal to (SCKPCS + 1) cycles of the LPSPI functional clock divided by the PRESCALE configuration, and the minimum delay is 1 cycle.
23–16 PCSSCK	PCS to SCK Delay Configures the delay in master mode from the PCS assertion to the first SCK edge. The delay is equal to (PCSSCK + 1) cycles of the LPSPI functional clock divided by the PRESCALE configuration, and the minimum delay is 1 cycle.
15–8 DBT	Delay Between Transfers Configures the delay in master mode from the PCS negation to the next PCS assertion. The delay is equal to (DBT + 2) cycles of the LPSPI functional clock divided by the PRESCALE configuration, and the minimum delay is 2 cycles. Note that half the delay occurs before PCS assertion and the other half of the delay occurs after PCS negation; the full command word can only update in the middle. Also configures the delay in master mode from the last SCK edge of a transfer word and the first SCK edge of the next transfer word in a continuous transfer. The delay is equal to (DBT + 1) cycles of the LPSPI functional clock divided by the PRESCALE configuration, and the minimum delay is 1 cycle.
SCKDIV	SCK Divider Configures the divide ratio of the SCK pin in master mode. The SCK period is equal to (SCKDIV+2) cycles of the LPSPI functional clock divided by the PRESCALE configuration, and the minimum period is 2 cycles. If the period is an odd number of cycles, then the first half of the period will be one cycle longer than the second half of the period.

44.3.12 FIFO Control Register (LPSPIx_FCR)

Address: Base address + 58h offset

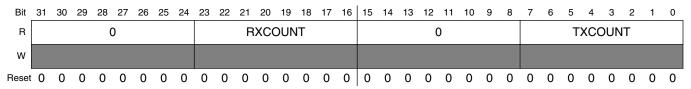


LPSPIx FCR field descriptions

Field	Description
31–24 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
23–16 RXWATER	Receive FIFO Watermark The Receive Data Flag is set whenever the number of words in the receive FIFO is greater than RXWATER. Writing a value equal or greater than the FIFO size will be truncated.
15–8 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
TXWATER	Transmit FIFO Watermark The Transmit Data Flag is set whenever the number of words in the transmit FIFO is equal or less than TXWATER. Writing a value equal or greater than the FIFO size will be truncated.

44.3.13 FIFO Status Register (LPSPIx_FSR)

Address: Base address + 5Ch offset



LPSPIx_FSR field descriptions

Field	Description
31–24 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
23-16 RXCOUNT	Receive FIFO Count Returns the number of words in the receive FIFO.
15–8 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
TXCOUNT	Transmit FIFO Count Returns the number of words in the transmit FIFO.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

44.3.14 Transmit Command Register (LPSPIx_TCR)

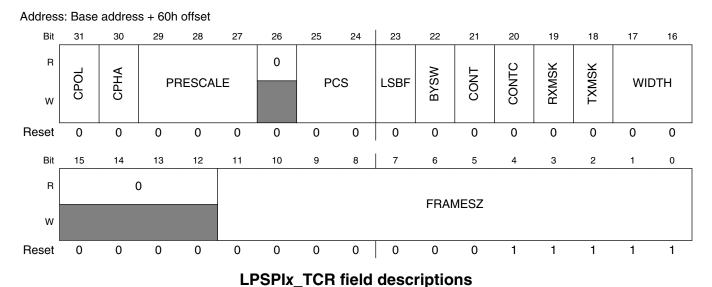
Writes to either the Transmit Command Register or Transmit Data Register will push the data into the transmit FIFO in the order they are written. Command Register writes will be tagged and cause the command register to update once that entry reaches the top of the FIFO. This allows changes to the command word and the transmit data itself to be interleaved. Changing the command word will cause all subsequent SPI bus transfer to be performed using the new command word.

In master mode, writing a new command word does not initiate a new transfer, unless TXMSK is set. Transfers are initiated by transmit data in the transmit FIFO, or a new command word with TXMSK set. Hardware will clear TXMSK when the LPSPI_PCS negates.

In master mode if the command word is changed before an existing frame has completed, then the existing frame will terminate and the command word will then update. The command word can be changed during a continuous transfer, provided CONTC of the new command word is set and the command word is written on a frame size boundary.

In slave mode, the command word should be changed only when the LPSPI is idle and there is no SPI bus transfer.

Reading the Transmit Command Register will return the current state of the command register.



Field Description 31 Clock Polarity CPOL This field is only updated between frames.

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

LPSPIx_TCR field descriptions (continued)

Field	Description
	0 The inactive state value of SCK is low.
	1 The inactive state value of SCK is high.
30 CPHA	Clock Phase
	This field is only updated between frames.
	 Data is captured on the leading edge of SCK and changed on the following edge. Data is changed on the leading edge of SCK and captured on the following edge.
29–27	Prescaler Value
PRESCALE	
	Prescaler applied to the clock configuration register for all SPI bus transfers. This field is only updated between frames.
	000 Divide by 1.
	001 Divide by 2.
	010 Divide by 4.
	011 Divide by 8.
	100 Divide by 16.
	101 Divide by 32.
	110 Divide by 64.
	111 Divide by 128.
26 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
25–24	Peripheral Chip Select
PCS	Configures the peripheral chip select used for the transfer. This field is only updated between frames.
	00 Transfer using LPSPI_PCS[0]
	01 Transfer using LPSPI_PCS[1]
	10 Transfer using LPSPI_PCS[2]
	11 Transfer using LPSPI_PCS[3]
23 LSBF	LSB First
	0 Data is transferred MSB first.
	1 Data is transferred LSB first.
22 BYSW	Byte Swap
	Byte swap will swap the contents of [31:24] with [7:0] and [23:16] with [15:8] for each transmit data word read from the FIFO and each received data word stored to the FIFO (or compared with match registers).
	0 Byte swap disabled.
	Byte swap enabled.
21	Continuous Transfer
CONT	
	In master mode, continuous transfer will keep the PCS asserted at the end of the frame size, until a command word is received that starts a new frame.
	In slave mode, when continuous transfer is enabled the LPSPI will only transmit the first FRAMESZ bits, after which it will transmit received data assuming a 32-bit shift register.

Table continues on the next page...

Memory Map and Registers

LPSPIx_TCR field descriptions (continued)

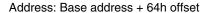
Field	Description
	0 Continuous transfer disabled.
	1 Continuous transfer enabled.
20	Continuing Command
CONTC	In master mode, this bit allows the command word to be changed within a continuous transfer. The initial command word must enable continuous transfer (CONT=1), the continuing command must set this bit (CONTC=1) and the continuing command word must be loaded on a frame size boundary. For example, if the continuous transfer has a frame size of 64-bits, then a continuing command word must be loaded on a 64-bit boundary. O Command word for start of new transfer.
	1 Command word for continuing transfer.
19	Receive Data Mask
RXMSK	When set, receive data is masked (receive data is not stored in receive FIFO).
	0 Normal transfer.
	1 Receive data is masked.
18 TXMSK	Transmit Data Mask When set, transmit data is masked (no data is loaded from transmit FIFO and output pin is tristated). In master mode, this bit will initiate a new transfer which cannot be aborted by another command word and the bit will be cleared by hardware at the end of the transfer.
	OO. Noward to profess
	00 Normal transfer. 01 Mask transmit data.
17.10	
17–16 WIDTH	Transfer Width
	Either RXMSK or TXMSK must be set for 2-bit or 4-bit transfers.
	00 Single bit transfer.
	01 Two bit transfer.
	10 Four bit transfer.
	11 Reserved.
15–12	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
FRAMESZ	Frame Size
	Configures the frame size in number of bits equal to (FRAMESZ + 1). The minimum frame size is 8 bits. If the frame size is larger than 32 bits, data will be loaded from the transmit FIFO and stored to the receive FIFO every 32 bits. If the size of the transfer word is not divisible by 32, then the last load of the transmit FIFO and store of the receive FIFO will contain the remainder bits (e.g.: a 72-bit transfer will load/store 32-bits from the FIFO and then another 32-bits from the FIFO and then the final 8-bits from the FIFO).

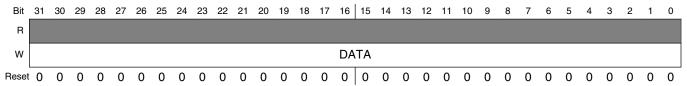
Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

1111

44.3.15 Transmit Data Register (LPSPIx_TDR)

Writes to either the Transmit Command Register or Transmit Data Register will push the data into the transmit FIFO in the order it was written.

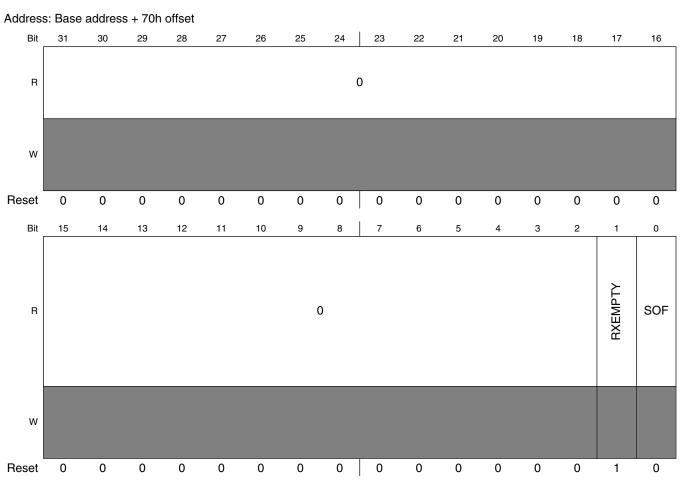




LPSPIx_TDR field descriptions

Field	Description
	Transmit Data Both 8-bit and 16-bit writes of transmit data will zero extend the data written and push the data into the transmit FIFO.

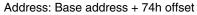
44.3.16 Receive Status Register (LPSPIx_RSR)

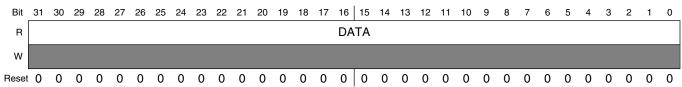


LPSPIx_RSR field descriptions

Field	Description
31–2 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
1 RXEMPTY	RX FIFO Empty 0 RX FIFO is not empty. 1 RX FIFO is empty.
0 SOF	Start Of Frame Indicates that this is the first data word received after LPSPI_PCS assertion. Undicates that this is the first data word received after LPSPI_PCS assertion. First data word received after LPSPI_PCS assertion.

44.3.17 Receive Data Register (LPSPIx_RDR)





LPSPIx_RDR field descriptions

Field	Description
DATA	Receive Data

44.4 Functional description

44.4.1 Clocking and Resets

44.4.1.1 Functional clock

The LPSPI functional clock is asynchronous to the bus clock and can remain enabled in low power modes to support SPI bus transfers in both master and slave modes. If the functional clock is disabled in slave mode, the LPSPI can transfer a single word before the functional clock needs to be enabled. The LPSPI divides the functional clock by a prescaler and the resulting frequency must be at least two times faster than the SPI clock frequency.

44.4.1.2 External clock

The LPSPI shift register is clocked directly by the external pins. This allows the LPISPI slave to remain operational in low power modes, even when the LPSPI functional clock is disabled, although this is limited to a single word transfer.

Functional description

44.4.1.3 Bus clock

The bus clock is only used for bus accesses to the control and configuration registers. The bus clock frequency must be sufficient to support the data bandwidth requirements of the LPSPI registers, including FIFOs.

44.4.1.4 Chip reset

The logic and registers for the LPSPI are reset to their default state on a chip reset.

44.4.1.5 Software reset

The LPSPI implements a software reset bit in the Control Register. The MCR[RST] will reset all logic and registers to their default state, except for the MCR itself.

44.4.1.6 FIFO reset

The LPSPI implements write-only control bits that resets the transmit/command FIFO (MCR[RTF] and receive FIFO (MCR[RRF]). A FIFO is empty after being reset.

44.4.2 Master Mode

44.4.2.1 Transmit and Command FIFO

The transmit and command FIFO is a combined FIFO that includes both transmit data and command words. Command words are stored to the transmit/command FIFO by writing the transmit command register. Transmit data words are stored to the transmit/command FIFO by writing the transmit data register.

When a command word is at the top of the transmit/command FIFO, the following actions can occur:

- If the LPSPI is between frames, the command word is pulled from the FIFO and controls all subsequent transfers.
- If the LPSPI is busy and either the existing CONT bit is clear or the new CONTC value is clear, the SPI frame will complete at the end of the existing word, ignoring

- the FRAMESZ configuration. The command word is then pulled from the FIFO and controls all subsequent transfers (or until the next update to the command word).
- If the LPSPI is busy and the existing CONT bit is set and the new CONTC value is set, the command word is pulled from the FIFO during the last LPSPI_SCK pulse of the existing frame (based on FRAMESZ configuration) and the frame continues using the new command value for the rest of the frame (or until the next update to the command word). When CONTC is set, only the lower 24-bits of the command word are updated.

The current state of the existing command word can be read by reading the transmit command register. It requires at least three LPSPI functional clock cycles for the transmit command register to update after it is written (assuming an empty FIFO) and the LPSPI must be enabled (MCR[MEN] is set).

Writing the transmit command register does not initiate a SPI bus transfer, unless the TXMSK bit is set. When TXMSK is set, a new command word will not be loaded until the end of the existing frame (based on FRAMESZ configuration) and the TXMSK bit will be cleared at the end of the transfer.

The following table describes the attributes that are controlled by the command word.

Description **Modify During Transfer Field CPOL** Configures polarity of the LPSPI_SCK pin. Any change of CPOL value will cause a transition on the LPSPI SCK pin. **CPHA** Configures clock phase of transfer. N **PRESCALE** Ν Configures prescaler used to divide the LPSPI functional clock to generate the timing parameters of the SPI bus transfer. Changing PRESCALE in conjunction with PCS allows the LPSPI to connect to different slave devices at different frequencies. **PCS** Configures which LPSPI PCS asserts for the transfer, the polarity of LPSPI_PCS is static and configured by PCSPOL. If PCSCFG is set, then PCS[3:2] should not be selected. Configures if LSB (bit 0) or MSB (bit 31 Υ **LSBF** for a 32-bit word) is transmitted/received first. **BYSW** Υ Enables byte swap on each 32-bit word when transmitting and receiving data. Can be useful when interfacing to devices that organize data as big endean.

Table 44-3. LPSPI Command Word

Table continues on the next page...

Functional description

Table 44-3. LPSPI Command Word (continued)

Field	Description	Modify During Transfer
CONT	Configures for a continuous transfer that keeps PCS asserted between frames (as configured by FRAMESZ). A new command word is required to cause PCS to negate. Also supports changing the command word at frame size boundaries.	Y
CONTC	Indicates this is a new command word for the existing continuous transfer. This bit is ignored when not written to the transmit/command FIFO on a frame boundary.	Y
RXMSK	Masks the receive data and does not store to the receive FIFO or perform receive data matching. Useful for half-duplex transfers or to configure which fields are compared during receive data matching.	Y
TXMSK	Masks the transmit data, so that data is not pulled from transmit FIFO and the output data pin is tristated (unless configured by OUTCFG). Useful for half-duplex transfers.	Y
WIDTH	Configures the number of bits shifted on each LPSPI_SCK pulse. Single bit transfers support traditional SPI bus transfers in either half-duplex or full-duplex data formats. Two and four bit transfers are useful for interfacing to QuadSPI memory devices and only support half-duplex data formats (at least one of TXMSK or RXMSK must also be set).	Y
FRAMESZ	Configures the number of bits in each frame to FRAMESZ+1. The minimum frame size is 8-bits and the maximum frame size is 4096-bits. If the frame size is less than or equal to 32-bits, the word size and frame size are identical. If the frame size is greater than 32-bits, then the word size is 32-bits for each word except the last (the last word contains the remainder bits if the frame size is not divisible by 32). The minimum word size is 2-bits, a frame size of 33-bits (or similar) is not supported.	Y

The LPSPI initiates a SPI bus transfer when data is written to the transmit FIFO, the HREQ pin is asserted (or disabled) and the LPSPI is enabled. The SPI bus transfer uses the attributes configured in the transmit command register and timing parameters from the clock configuration register to perform the transfer. The SPI bus transfer ends once

the FRAMESZ configuration is reached, or at the end of a word when a new transmit command word is at the top of the transmit/command FIFO. The HREQ input is only checked the next time the LPSPI goes idle (completes the current transfer and transmit/ command register is empty).

The transmit/command FIFO also supports a Circular FIFO feature. This allows the LPSPI master to (periodically) repeat a short data transfer that can fit within the transmit/ command FIFO, without requiring additional FIFO accesses. When the circular FIFO is enabled, the current state of the FIFO read pointer is saved and the status flags do not update. Once the transmit/command FIFO is considered empty and the LPSPI is idle, the FIFO read pointer is restored with the saved version, so the contents of the transmit/ command FIFO are not permanently pulled from the FIFO while circular FIFO mode is enabled.

44.4.2.2 **Receive FIFO and Data Match**

The receive FIFO is used to store receive data during SPI bus transfers. When RXMSK is set, receive data is discarded instead of storing in the receive FIFO.

Receive data supports a receive data match function that can match received data against one of two words or against a masked data word. The data match function can also be configured to compare only the first one or two received data words since the start of the frame. Receive data that is already discarded due to RXMSK bit cannot cause the data match to set and will delay the match on first received data word until after all discarded data is received. The receiver match function can also be configured to discard all receive data until a data match is detected, using the MCFGR0[RDMO] control bit. When clearing the MCFGR0[RDMO] control bit following a data match, clear MCFGR0[RDMO] before clearing MSR[DMF] to allow all subsequent data to be received.

Timing Parameters 44.4.2.3

The following table lists the timing parameters that are used for all SPI bus transfers, these timing parameters are relative to the LPSPI functional clock divided by the PRESCALE configuration. Although the Clock Configuration Register cannot be changed when the LPSPI is busy, the PRESCALE configuration can be altered between transfers using the command register, to support interfacing to different slave devices at different frequencies.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

1117

Functional description

Table 44-4. LPSPI Timing Parameters

Field	Description	Min	Max
SCKDIV	Configures the LPSPI_SCK clock period to (SCKDIV+2) cycles. When configured to an odd number of cycles, the first half of the LPSPI_SCK cycle is one cycle longer than the second half.	0 (2 cycles)	255 (257 cycles)
DBT	Configures the minimum delay between PCS negation and the next PCS assertion to (DBT + 2) cycles. When the command word is updated between transfers, there is a minimum of (DBT/2)+1 cycles between the command word update and any change on LPSPI_PCS pins.	0 (2 cycles)	255 (257 cycles)
DBT	Configures the delay during a continuous transfer between the last SCK edge of a frame and the first SCK edge of the continuing frame to (DBT + 1) cycles. This is useful where the external slave requires a large delay between different words of a SPI bus transfer.	0 (1 cycle)	255 (256 cycles)
PCSSCK	Configures the minimum delay between PCS assertion and the first SCK edge to (PCSSCK + 1) cycles.	0 (1 cycle)	255 (256 cycles)
SCKPCS	Configures the minimum delay between the last SCK edge and the PCS assertion to (SCKPCS + 1) cycles.	0 (1 cycle)	255 (256 cycles)

44.4.2.4 Pin Configuration

The LPSPI_SIN and LPSPI_SOUT pins can be configured via the PINCFG configuration to swap directions or even support half-duplex transfers on the same pin.

The OUTCFG configuration can be used to determine if output data pin (eg: LPSPI_SOUT) will tristate when the LPSPI_PCS is negated, or if it will simply retain the last value. When configuring for half-duplex transfers using the same data pin in single bit transfer mode, or any transfer in 2-bit and 4-bit transfer modes, then the output data pins must be configured to tristate when LPSPI_PCS is negated.

The PCSCFG configuration is used to disable LPSPI_PCS[3:2] functions and to use them for quad-data transfers. This option must be enabled when performing quad-data transfers.

44.4.3 Slave Mode

LPSPI slave mode uses the same shift register and logic as the master mode, but does not use the clock configuration register and the transmit command register must remain static during SPI bus transfers.

44.4.3.1 Transmit and Command FIFO

The transmit command register should be initialized before enabling the LPSPI in slave mode, although the command register will not update until after the LPSPI is enabled. Once enabled, the transmit command register should only be changed if the LPSPI is idle. The following table lists how the command register functions in slave mode.

Table 44-5. LPSPI Command Word in Slave Mode

Field	Description
CPOL	Configures polarity of the external LPSPI_SCK input.
СРНА	Configures clock phase of transfer.
PRESCALE	Configures LPSPI functional clock prescaler.
PCS	Configures which LPSPI_PCS is used, the polarity of LPSPI_PCS is static and configured by PCSPOL. If PCSCFG is set, then PCS[3:2] should not be selected.
LSBF	Configures if LSB (bit 0) or MSB (bit 31 for a 32-bit word) is transmitted/received first.
BYSW	Enables byte swap on each 32-bit word when transmitting and receiving data. Can be useful when interfacing to devices that organize data as big endean.
CONT	When set, only the first FRAMSZ bits will be transmitted/ received by the LPSPI.
CONTC	This bit is reserved in slave mode.
RXMSK	Masks the receive data and does not store to the receive FIFO or perform receive data matching. Useful for half-duplex transfers or to configure which fields are compared during receive data matching.
TXMSK	Masks the transmit data, so that data is not pulled from transmit FIFO and the output data pin is tristated (unless configured by OUTCFG). Useful for half-duplex transfers.
WIDTH	Configures the number of bits shifted on each LPSPI_SCK pulse. Single bit transfers support traditional SPI bus transfers in either half-duplex or full-duplex data formats. Two and four bit transfers are useful for interfacing to QuadSPI memory

Table continues on the next page...

Table 44-5. LPSPI Command Word in Slave Mode (continued)

Field	Description
	devices and only support half-duplex data formats (at least one of TXMSK or RXMSK must also be set).
FRAMESZ	Configures the number of bits in each frame to FRAMESZ+1. The minimum frame size is 8-bits and the maximum frame size is 4096-bits. If the frame size is less than or equal to 32-bits, the word size and frame size are identical. If the frame size is greater than 32-bits, then the word size is 32-bits for each word except the last (the last word contains the remainder bits if the frame size is not divisible by 32). The minimum word size is 2-bits, a frame size of 33-bits (or similar) is not supported.

The transmit FIFO must be filled with transmit data before the LPSPI_PCS input asserts, otherwise the transmit error flag will set.

44.4.3.2 Receive FIFO and Data Match

The receive FIFO is used to store receive data during SPI bus transfers. When RXMSK is set, receive data is discarded instead of storing in the receive FIFO.

Receive data supports a receive data match function that can match received data against one of two words or against a masked data word. The data match function can also be configured to compare only the first one or two received data words since the start of the frame. Receive data that is already discarded due to RXMSK bit cannot cause the data match to set and will delay the match on first received data word until after all discarded data is received. The receiver match function can also be configured to discard all receive data until a data match is detected, using the MCFGR0[RDMO] control bit. When clearing the MCFGR0[RDMO] control bit following a data match, clear MCFGR0[RDMO] before clearing MSR[DMF] to allow all subsequent data to be received.

44.4.3.3 Clocked Interface

The LPSPI supports interfacing to external masters that provide only clock and data pins (LPSPI_PCS is not required). This requires using CPHA=1, configuring the LPSPI_PCS input to be always asserted (configure PCSPOL) and setting the AUTOPCS bit. When AUTOPCS is set, a minimum of four LPSPI functional clock cycles (divided by PRESCALE configuration) is required between the last LPSPI_SCK edge of one word and the first LPSPI_SCK edge of the next word.

44.4.4 Interrupts and DMA Requests

The following table illustrates the status flags that can generate the LPSPI interrupt and LPSPI transmit/receive DMA requests.

Table 44-6. LPSPI Interrupts and DMA Requests

Flag	Description	Interrupt	DMA Request	Low Power Wakeup
TDF	Data can be written to transmit FIFO, as configured by TXWATER.	Y	ТХ	Y
RDF	Data can be read from the receive FIFO, as configured by RXWATER.	Y	RX	Y
WCF	Word complete, last bit of word has been sampled.	Y	N	Y
FCF	Frame complete, PCS has negated .	Υ	N	Y
TCF	Transfer complete, PCS has negated and transmit/command FIFO is empty.	Y	N	Y
TEF	Transmit error flag, indicates transmit/ command FIFO underrun. This bit cannot set in master mode when NOSTALL is clear.	Y	N	Y
REF	Receive error flag, indicates receive FIFO overflow. This bit cannot set in master mode when NOSTALL is clear.	Y	N	Y
DMF	Data match flag, received data has matched the configured data match value.	Y	N	Y
MBF	LPSPI is busy performing a SPI bus transfer.	N	N	N

Functional description

44.4.5 Peripheral Triggers

The connection of the LPSPI peripheral triggers with other peripherals are device specific.

44.4.5.1 Output Triggers

The LPSPI generates two output triggers that can be connected to other peripherals on the device. The frame output trigger asserts at the end of each frame (when PCS negates) and remains asserted until PCS next asserts. The word output trigger asserts at the end of each received word and remains asserted for one LPSPI_SCK period.

44.4.5.2 Input Trigger

The LPSPI input trigger can be selected in place of the LPSPI_HREQ input to control the start of a LPSPI bus transfer. The input trigger must assert for longer than one LPSPI functional clock cycle to be detected.

Chapter 45 Low Power Inter-Integrated Circuit (LPI2C)

45.1 Chip-specific information for this module

45.1.1 Instantiation Information

This device has two LPI2C modules. The LPI2C can remain functional in Stop and VLPS mode provided the clock it is using remains enabled.

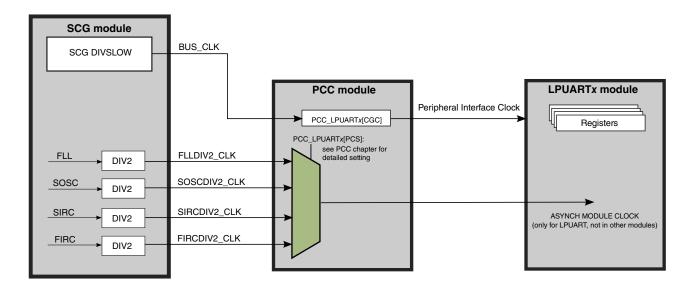
Table 45-1. LPI2C Configuration

	TX FIFO (word/8bit)	RX FIFO (word/8bit)	SMBus	Slave mode enable
LPI2C0	4	4	Yes	Yes
LPI2C1	4	4	Yes	Yes

45.1.2 Module Clocking Information for LPUART, LPSPI, LPI2C, FlexIO and LPIT

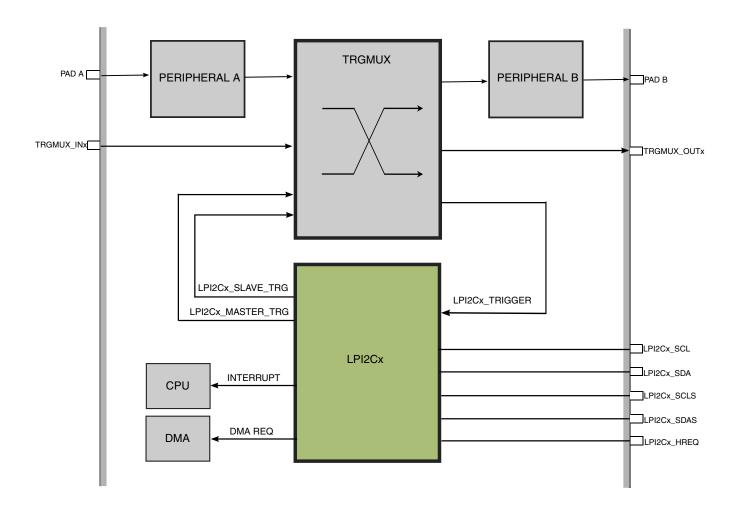
The following figure shows the input clock sources available for this module.

Peripheral Clocking - LPUART Note: this example figure also applies similarly to the clocking for LPSPI, LPI2C, and LPIT.



45.1.3 **Inter-connectivity Information**

The LPI2C inter-connectivity is shown in following diagram.



45.2 Introduction

45.2.1 Overview

The LPI2C is a low power Inter-Integrated Circuit (I2C) module that supports an efficient interface to an I2C bus as a master and/or a slave. The LPI2C can continue operating in stop modes provided an appropriate clock is available and is designed for low CPU overhead with DMA offloading of FIFO register accesses. The LPI2C implements logic support for standard-mode, fast-mode plus and ultra-fast modes of operation. The LPI2C module also complies with the System Management Bus (SMBus) Specification, version 2.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

45.2.2 Features

The LPI2C supports the following features of the I2C specification:

- Standard, Fast, Fast+ and Ultra Fast modes are supported.
- HS-mode supported in slave mode.
- HS-mode supported for master mode, provided SCL pin implements current source pull-up (device specific).
- Multi-master support including synchronization and arbitration.
- Clock stretching.
- General call, 7-bit and 10-bit addressing.
- Software reset, START byte and Device ID require software support.

The LPI2C master supports the following features:

- Command/transmit FIFO of 4 words.
- Receive FIFO of 4 words.
- Command FIFO will wait for idle I2C bus before initiating transfer
- Command FIFO can initiate (repeated) START and STOP conditions and one or more master-receiver transfers.
- STOP condition can be generated from command FIFO or automatically when the transmit FIFO is empty.
- Host request input can be used to control the start time of an I2C bus transfer.
- Flexible receive data match can generate interrupt on data match and/or discard unwanted data.
- Flag and optional interrupt to signal Repeated START condition, STOP condition, loss of arbitration, unexpected NACK and command word errors.
- Supports configurable bus idle timeout and pin stuck low timeout.

The LPI2C slave supports the following features:

- Separate I2C slave registers to minimize software overhead due to master/slave switching.
- Support for 7-bit or 10-bit addressing, address range, SMBus alert and general call address.
- Transmit data register supporting interrupt or DMA requests.
- Receive data register supporting interrupt or DMA requests.
- Software controllable ACK or NACK, with optional clock stretching on ACK/NACK bit.
- Configurable clock stretching to avoid transmit FIFO underrun and receive FIFO overrun.
- Flag and optional interrupt at end of packet, STOP condition or bit error detection.

45.2.3 Block Diagram

Trigger Peripheral HREQ Bus Command / TX **FIFO** SDA Glitch Master RX Logic Filter FIFO SCL Configuration Registers Master Slave TX Data Slave SDAS Glitch RX Data / Logic Filter Address SCLS Configuration Registers

LPI2C block diagram

Figure 45-1. LPI2C block diagram

Functional Clock

1127

45.2.4 Modes of operation

Bus Clock

The LPI2C module supports the chip modes described in the following table.

External Clock

Clock Domains

Memory Map and Registers

Table 45-2. Chip modes supported by the LPI2C module

Chip mode	LPI2C Operation
Run	Normal operation
Stop/Wait	Can continue operating provided the Doze Enable bit (MCR[DOZEN]) is set and the LPI2C is using an external or internal clock source which remains operating during stop/wait modes.
Debug	Can continue operating provided the Debug Enable bit (MCR[DBGE]) is set.

45.2.5 Signal Descriptions

Signal	Description	I/O
SCL	LPI2C clock line. In 4-wire mode, this is the SCL input pin.	I/O
SDA	LPI2C data line. In 4-wire mode, this is the SDA input pin.	I/O
HREQ	Host request, can initiate an LPI2C master transfer if asserted and the I2C bus is idle.	I
SCLS	Secondary I2C clock line. In 4-wire mode, this is the SCL output pin. If LPI2C master/slave are configured to use separate pins, this the LPI2C slave SCL pin.	I/O
SDAS	Secondary I2C data line. In 4-wire mode, this is the SDA output pin. If LPI2C master/slave are configured to use separate pins, this the LPI2C slave SDA pin.	I/O

45.3 Memory Map and Registers

LPI2C memory map

Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page
4006_6000	Version ID Register (LPI2C0_VERID)	32	R	See section	45.3.1/1131
4006_6004	Parameter Register (LPI2C0_PARAM)	32	R	See section	45.3.2/1131
4006_6010	Master Control Register (LPI2C0_MCR)	32	R/W	0000_0000h	45.3.3/1132
4006_6014	Master Status Register (LPI2C0_MSR)	32	R/W	0000_0001h	45.3.4/1133
4006_6018	Master Interrupt Enable Register (LPI2C0_MIER)	32	R/W	0000_0000h	45.3.5/1135
4006_601C	Master DMA Enable Register (LPI2C0_MDER)	32	R/W	0000_0000h	45.3.6/1137

Table continues on the next page...

NXP Semiconductors

LPI2C memory map (continued)

Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page
4006_6020	Master Configuration Register 0 (LPI2C0_MCFGR0)	32	R/W	0000_0000h	45.3.7/1138
4006_6024	Master Configuration Register 1 (LPI2C0_MCFGR1)	32	R/W	0000_0000h	45.3.8/1139
4006_6028	Master Configuration Register 2 (LPI2C0_MCFGR2)	32	R/W	0000_0000h	45.3.9/1141
4006_602C	Master Configuration Register 3 (LPI2C0_MCFGR3)	32	R/W	0000_0000h	45.3.10/ 1142
4006_6040	Master Data Match Register (LPI2C0_MDMR)	32	R/W	0000_0000h	45.3.11/ 1142
4006_6048	Master Clock Configuration Register 0 (LPI2C0_MCCR0)	32	R/W	0000_0000h	45.3.12/ 1143
4006_6050	Master Clock Configuration Register 1 (LPI2C0_MCCR1)	32	R/W	0000_0000h	45.3.13/ 1144
4006_6058	Master FIFO Control Register (LPI2C0_MFCR)	32	R/W	0000_0000h	45.3.14/ 1145
4006_605C	Master FIFO Status Register (LPI2C0_MFSR)	32	R	0000_0000h	45.3.15/ 1145
4006_6060	Master Transmit Data Register (LPI2C0_MTDR)	32	W	0000_0000h	45.3.16/ 1146
4006_6070	Master Receive Data Register (LPI2C0_MRDR)	32	R	0000_4000h	45.3.17/ 1147
4006_6110	Slave Control Register (LPI2C0_SCR)	32	R/W	0000_0000h	45.3.18/ 1148
4006_6114	Slave Status Register (LPI2C0_SSR)	32	R/W	0000_0000h	45.3.19/ 1149
4006_6118	Slave Interrupt Enable Register (LPI2C0_SIER)	32	R/W	0000_0000h	45.3.20/ 1152
4006_611C	Slave DMA Enable Register (LPI2C0_SDER)	32	R/W	0000_0000h	45.3.21/ 1153
4006_6124	Slave Configuration Register 1 (LPI2C0_SCFGR1)	32	R/W	0000_0000h	45.3.22/ 1154
4006_6128	Slave Configuration Register 2 (LPI2C0_SCFGR2)	32	R/W	0000_0000h	45.3.23/ 1156
4006_6140	Slave Address Match Register (LPI2C0_SAMR)	32	R/W	0000_0000h	45.3.24/ 1157
4006_6150	Slave Address Status Register (LPI2C0_SASR)	32	R	0000_4000h	45.3.25/ 1158
4006_6154	Slave Transmit ACK Register (LPI2C0_STAR)	32	R/W	0000_0000h	45.3.26/ 1159
4006_6160	Slave Transmit Data Register (LPI2C0_STDR)	32	W	0000_0000h	45.3.27/ 1159
4006_6170	Slave Receive Data Register (LPI2C0_SRDR)	32	R	0000_4000h	45.3.28/ 1160
4006_7000	Version ID Register (LPI2C1_VERID)	32	R	See section	45.3.1/1131
4006_7004	Parameter Register (LPI2C1_PARAM)	32	R	See section	45.3.2/1131

Table continues on the next page...

Memory Map and Registers

LPI2C memory map (continued)

Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page
4006_7010	Master Control Register (LPI2C1_MCR)	32	R/W	0000_0000h	45.3.3/1132
4006_7014	Master Status Register (LPI2C1_MSR)	32	R/W	0000_0001h	45.3.4/1133
4006_7018	Master Interrupt Enable Register (LPI2C1_MIER)	32	R/W	0000_0000h	45.3.5/1135
4006_701C	Master DMA Enable Register (LPI2C1_MDER)	32	R/W	0000_0000h	45.3.6/1137
4006_7020	Master Configuration Register 0 (LPI2C1_MCFGR0)	32	R/W	0000_0000h	45.3.7/1138
4006_7024	Master Configuration Register 1 (LPI2C1_MCFGR1)	32	R/W	0000_0000h	45.3.8/1139
4006_7028	Master Configuration Register 2 (LPI2C1_MCFGR2)	32	R/W	0000_0000h	45.3.9/1141
4006_702C	Master Configuration Register 3 (LPI2C1_MCFGR3)	32	R/W	0000_0000h	45.3.10/ 1142
4006_7040	Master Data Match Register (LPI2C1_MDMR)	32	R/W	0000_0000h	45.3.11/ 1142
4006_7048	Master Clock Configuration Register 0 (LPI2C1_MCCR0)	32	R/W	0000_0000h	45.3.12/ 1143
4006_7050	Master Clock Configuration Register 1 (LPI2C1_MCCR1)	32	R/W	0000_0000h	45.3.13/ 1144
4006_7058	Master FIFO Control Register (LPI2C1_MFCR)	32	R/W	0000_0000h	45.3.14/ 1145
4006_705C	Master FIFO Status Register (LPI2C1_MFSR)	32	R	0000_0000h	45.3.15/ 1145
4006_7060	Master Transmit Data Register (LPI2C1_MTDR)	32	W	0000_0000h	45.3.16/ 1146
4006_7070	Master Receive Data Register (LPI2C1_MRDR)	32	R	0000_4000h	45.3.17/ 1147
4006_7110	Slave Control Register (LPI2C1_SCR)	32	R/W	0000_0000h	45.3.18/ 1148
4006_7114	Slave Status Register (LPI2C1_SSR)	32	R/W	0000_0000h	45.3.19/ 1149
4006_7118	Slave Interrupt Enable Register (LPI2C1_SIER)	32	R/W	0000_0000h	45.3.20/ 1152
4006_711C	Slave DMA Enable Register (LPI2C1_SDER)	32	R/W	0000_0000h	45.3.21/ 1153
4006_7124	Slave Configuration Register 1 (LPI2C1_SCFGR1)	32	R/W	0000_0000h	45.3.22/ 1154
4006_7128	Slave Configuration Register 2 (LPI2C1_SCFGR2)	32	R/W	0000_0000h	45.3.23/ 1156
4006_7140	Slave Address Match Register (LPI2C1_SAMR)	32	R/W	0000_0000h	45.3.24/ 1157
4006_7150	Slave Address Status Register (LPI2C1_SASR)	32	R	0000_4000h	45.3.25/ 1158
4006_7154	Slave Transmit ACK Register (LPI2C1_STAR)	32	R/W	0000_0000h	45.3.26/ 1159
4006_7160	Slave Transmit Data Register (LPI2C1_STDR)	32	W	0000_0000h	45.3.27/ 1159

Table continues on the next page...

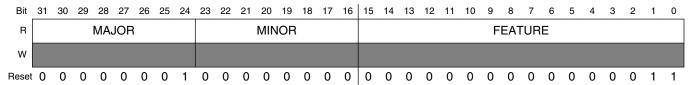
LPI2C memory map (continued)

Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page
4006_7170	Slave Receive Data Register (LPI2C1_SRDR)	32	R	0000_4000h	45.3.28/ 1160

45.3.1 Version ID Register (LPI2Cx_VERID)

•

Address: Base address + 0h offset



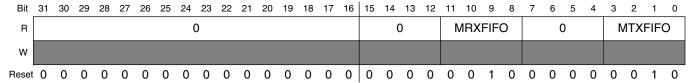
LPI2Cx_VERID field descriptions

Field	Description			
31–24 MAJOR	Major Version Number			
WAJON	This read only field returns the major version number for the specification.			
23–16 MINOR	Minor Version Number			
WillYOTT	This read only field returns the minor version number for the specification.			
FEATURE	Feature Specification Number			
	This read only field returns the feature set number.			
	0x0002 Master only with standard feature set.			
	0x0003 Master and slave with standard feature set.			

45.3.2 Parameter Register (LPI2Cx_PARAM)

•

Address: Base address + 4h offset

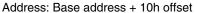


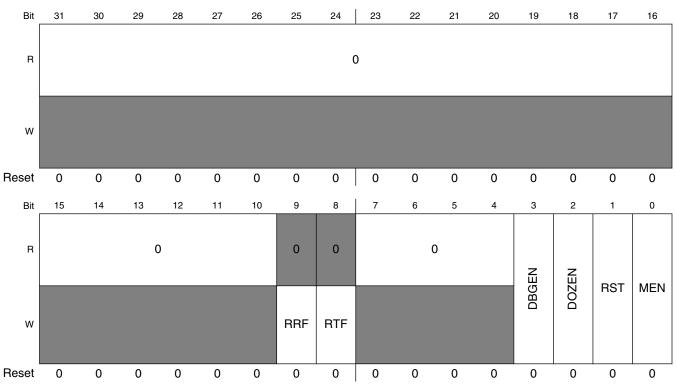
Memory Map and Registers

LPI2Cx_PARAM field descriptions

Field	Description
31–16 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
15–12 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
11–8 MRXFIFO	Master Receive FIFO Size The number of words in the master receive FIFO is 2^MRXFIFO.
7–4 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
MTXFIFO	Master Transmit FIFO Size
	The number of words in the master transmit FIFO is 2^MTXFIFO.

45.3.3 Master Control Register (LPI2Cx_MCR)





LPI2Cx_MCR field descriptions

Field	Description
31–10 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.

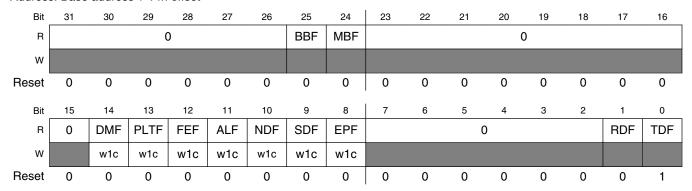
Table continues on the next page...

LPI2Cx_MCR field descriptions (continued)

Field	Description
9 RRF	Reset Receive FIFO
	0 No effect.
	1 Receive FIFO is reset.
8 RTF	Reset Transmit FIFO
	0 No effect.
	1 Transmit FIFO is reset.
7–4	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
3 DBGEN	Debug Enable
	0 Master is disabled in debug mode.
	1 Master is enabled in debug mode.
2 DOZEN	Doze mode enable
	Enables or disables Doze mode for the master.
	0 Master is enabled in Doze mode.
	1 Master is disabled in Doze mode.
1 RST	Software Reset
	Reset all internal master logic and registers, except the Master Control Register. Remains set until cleared by software.
	0 Master logic is not reset.
	1 Master logic is reset.
0 MEN	Master Enable
	0 Master logic is disabled.
	1 Master logic is enabled.

45.3.4 Master Status Register (LPI2Cx_MSR)

Address: Base address + 14h offset



Memory Map and Registers

LPI2Cx_MSR field descriptions

Field	Description
31–26 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
25 BBF	Bus Busy Flag
	0 I2C Bus is idle.1 I2C Bus is busy.
24 MBF	Master Busy Flag
2.	0 I2C Master is idle.1 I2C Master is busy.
23–15 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
14	Data Match Flag
DMF	Indicates that the received data has matched the MATCH0 and/or MATCH1 fields as configured by MATCFG. Received data that is discarded due to CMD field does not cause this flag to set.
	O Have not received matching data. Have received matching data.
13	Pin Low Timeout Flag
PLTF	Will set when the SCL and/or SDA input is low for more than PINLOW cycles, even when the LPI2C master is idle. Software is responsible for resolving the pin low condition. This flag cannot be cleared for as long as the pin low timeout continues and must be cleared before the LPI2C can initiate a START condition.
	0 Pin low timeout has not occurred or is disabled.1 Pin low timeout has occurred.
12 FEF	FIFO Error Flag
l Li	Detects an attempt to send or receive data without first generating a (repeated) START condition. This can occur if the transmit FIFO underflows when the AUTOSTOP bit is set. When this flag is set, the LPI2C master will send a STOP condition (if busy) and will not initiate a new START condition until this flag has been cleared.
	0 No error.
11	Master sending or receiving data without START condition. Arbitration Lost Flag
ALF	This flag will set if the LPI2C master transmits a logic one and detects a logic zero on the I2C bus, or if it detects a START or STOP condition while it is transmitting data. When this flag sets, the LPI2C master will release the bus (go idle) and will not initiate a new START condition until this flag has been cleared. O Master has not lost arbitration.
10	1 Master has lost arbitration.
NDF	NACK Detect Flag This flag will set if the LPI2C master detects a NACK when transmitting an address or data. If a NACK is expected for a given address (as configured by the command word) then the flag will set if a NACK is not generated. When set, the master will transmit a STOP condition and will not initiate a new START condition until this flag has been cleared.

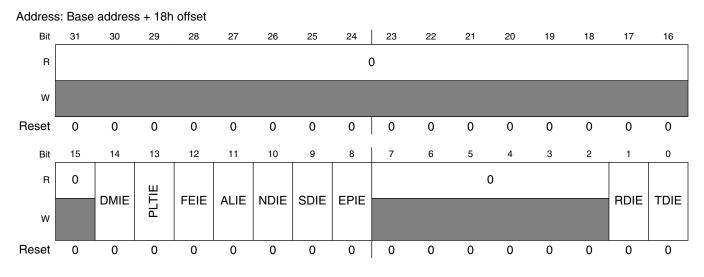
Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

LPI2Cx_MSR field descriptions (continued)

Field	Description
	0 Unexpected NACK not detected.
	1 Unexpected NACK was detected.
9 SDF	STOP Detect Flag
	This flag will set when the LPI2C master generates a STOP condition.
	0 Master has not generated a STOP condition.
	1 Master has generated a STOP condition.
8 EPF	End Packet Flag
	This flag will set when the LPI2C master generates either a repeated START or a STOP condition. It does not set when the master first generates a START condition.
	0 Master has not generated a STOP or Repeated START condition.
	1 Master has generated a STOP or Repeated START condition.
7–2	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
1 RDF	Receive Data Flag
RDF	The Receive Data Flag is set whenever the number of words in the receive FIFO is greater than RXWATER.
	0 Receive Data is not ready.
	1 Receive data is ready.
0 TDF	Transmit Data Flag
	The Transmit Data Flag is set whenever the number of words in the transmit FIFO is equal or less than TXWATER.
	0 Transmit data not requested.
	1 Transmit data is requested.

45.3.5 Master Interrupt Enable Register (LPI2Cx_MIER)



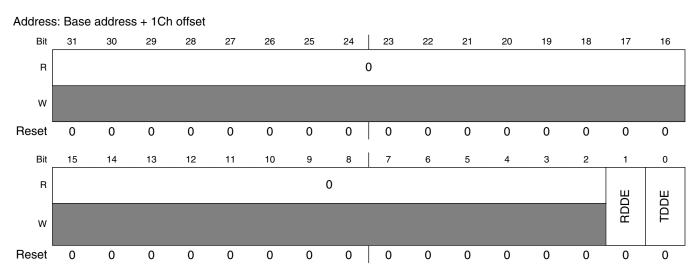
Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Memory Map and Registers

LPI2Cx_MIER field descriptions

Field	Description
31–15	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
14 DMIE	Data Match Interrupt Enable
DIVILE	0 Interrupt disabled.
	1 Interrupt enabled.
13	Pin Low Timeout Interrupt Enable
PLTIE	0 Interrupt disabled.
	Interrupt disabled. Interrupt enabled.
12	FIFO Error Interrupt Enable
FEIE	
	0 Interrupt disabled.
	1 Interrupt enabled.
11 ALIE	Arbitration Lost Interrupt Enable
ALIE	0 Interrupt disabled.
	1 Interrupt enabled.
10	NACK Detect Interrupt Enable
NDIE	0 Interrupt disabled.
	1 Interrupt enabled.
9	STOP Detect Interrupt Enable
SDIE	
	0 Interrupt disabled.
	1 Interrupt enabled.
8 EPIE	End Packet Interrupt Enable
	0 Interrupt disabled.
	1 Interrupt enabled.
7–2	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
1 RDIE	Receive Data Interrupt Enable
UDIE	0 Interrupt disabled.
	1 Interrupt enabled.
0	Transmit Data Interrupt Enable
TDIE	0 Interrupt disabled.
	1 Interrupt enabled

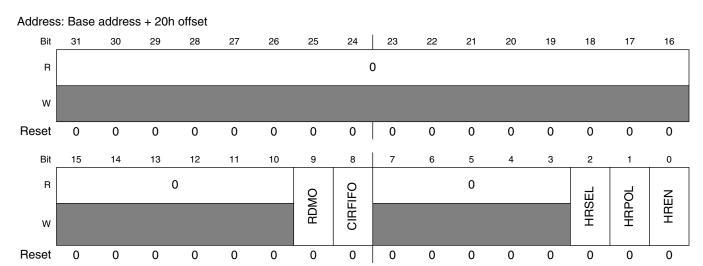
45.3.6 Master DMA Enable Register (LPI2Cx_MDER)



LPI2Cx_MDER field descriptions

Field	Description
31–2 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
1 RDDE	Receive Data DMA Enable 0 DMA request disabled. 1 DMA request enabled.
0 TDDE	Transmit Data DMA Enable 0 DMA request disabled. 1 DMA request enabled

45.3.7 Master Configuration Register 0 (LPI2Cx_MCFGR0)



LPI2Cx_MCFGR0 field descriptions

Field	Description
31–10 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
9 RDMO	Receive Data Match Only When enabled, all received data that does not cause DMF to set is discarded. Once DMF is set, the RDMO configuration is ignored. When disabling RDMO, clear RDMO before clearing DMF to ensure no receive data is lost. O Received data is stored in the receive FIFO as normal. Received data is discarded unless the RMF is set.
8 CIRFIFO	Circular FIFO Enable When enabled, the transmit FIFO read pointer is saved to a temporary register. The transmit FIFO will be emptied as normal, but once the LPI2C master is idle and the transmit FIFO is empty, then the read pointer value will be restored from the temporary register. This will cause the contents of the transmit FIFO to be cycled through repeatedly. If AUTOSTOP is set, a STOP condition will be sent whenever the transmit FIFO is empty and the read pointer is restored. O Circular FIFO is disabled. Circular FIFO is enabled.
7–3 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
2 HRSEL	Host Request Select Selects the source of the host request input. O Host request input is pin LPI2C_HREQ. Host request input is input trigger.
1 HRPOL	Host Request Polarity

Table continues on the next page...

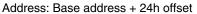
Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

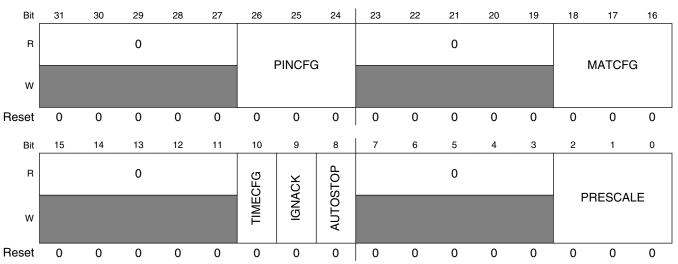
LPI2Cx_MCFGR0 field descriptions (continued)

Field	Description
	Configures the polarity of the host request input pin.
	0 Active low.
	1 Active high.
0 HREN	Host Request Enable
	When enabled, the LPI2C master will only initiate a START condition if the host request input is asserted and the bus is idle. A repeated START is not affected by the host request.
	0 Host request input is disabled.
	1 Host request input is enabled.

45.3.8 Master Configuration Register 1 (LPI2Cx_MCFGR1)

The MCFGR1 should only be written when the I2C Master is disabled.





LPI2Cx_MCFGR1 field descriptions

Field	Description
31–27 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
26–24 PINCFG	Pin Configuration Configures the pin mode.
	 LPI2C configured for 2-pin open drain mode. LPI2C configured for 2-pin output only mode (ultra-fast mode). LPI2C configured for 2-pin push-pull mode. LPI2C configured for 4-pin push-pull mode. LPI2C configured for 2-pin open drain mode with separate LPI2C slave.

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Memory Map and Registers

LPI2Cx_MCFGR1 field descriptions (continued)

Field	Description
	101 LPI2C configured for 2-pin output only mode (ultra-fast mode) with separate LPI2C slave.
	110 LPI2C configured for 2-pin push-pull mode with separate LPI2C slave.
	111 LPI2C configured for 4-pin push-pull mode (inverted outputs).
23–19	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
18-16 MATCFG	Match Configuration
	Configures the condition that will cause the DMF to set.
	000 Match disabled.
	001 Reserved.
	010 Match enabled (1st data word equals MATCH0 OR MATCH1).
	011 Match enabled (any data word equals MATCH0 OR MATCH1).
	100 Match enabled (1st data word equals MATCH0 AND 2nd data word equals MATCH1).
	101 Match enabled (any data word equals MATCH0 AND next data word equals MATCH1).
	110 Match enabled (1st data word AND MATCH1 equals MATCH0 AND MATCH1).
	111 Match enabled (any data word AND MATCH1 equals MATCH0 AND MATCH1).
15–11 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
10	Timeout Configuration
TIMECFG	0 Pin Low Timeout Flag will set if SCL is low for longer than the configured timeout.
	1 Pin Low Timeout Flag will set if either SCL or SDA is low for longer than the configured timeout.
9 IGNACK	When set, the received NACK field is ignored and assumed to be ACK. This bit is required to be set in Ultra-Fast Mode.
	0 LPI2C Master will receive ACK and NACK normally.
	LPI2C Master will receive ACK and NACK normally. LPI2C Master will treat a received NACK as if it was an ACK.
8	Automatic STOP Generation
8 AUTOSTOP	Automatic STOP Generation
7.0100101	When enabled, a STOP condition is generated whenever the LPI2C master is busy and the transmit FIFO is empty. The STOP condition can also be generated using a transmit FIFO command.
	0 No effect.
	1 STOP condition is automatically generated whenever the transmit FIFO is empty and LPI2C master is
	busy.
7–3 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
	· · · · · · · · · · · · · · · · · · ·
PRESCALE	Prescaler
	Configures the clock prescaler used for all LPI2C master logic, except the digital glitch filters.
	000 Divide by 1.
	001 Divide by 2.
	010 Divide by 4.
	011 Divide by 8.
	100 Divide by 16.
1	101 Divide by 32.

Table continues on the next page...

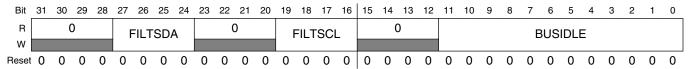
LPI2Cx_MCFGR1 field descriptions (continued)

Field	Description
	10 Divide by 64.
	11 Divide by 128.

45.3.9 Master Configuration Register 2 (LPI2Cx_MCFGR2)

The MCFGR2 should only be written when the I2C Master is disabled.

Address: Base address + 28h offset



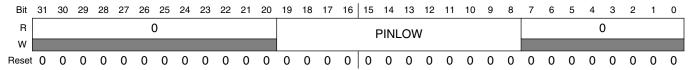
LPI2Cx_MCFGR2 field descriptions

Field	Description
31–28 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
27–24	Glitch Filter SDA
FILTSDA	Configures the I2C master digital glitch filters for SDA input, a configuration of 0 will disable the glitch filter. Glitches equal to or less than FILTSDA cycles long will be filtered out and ignored. The latency through the glitch filter is equal to FILTSDA cycles and must be configured less than the minimum SCL low or high period.
	The glitch filter cycle count is not affected by the PRESCALE configuration and is automatically bypassed in High Speed mode.
23–20 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
19–16	Glitch Filter SCL
FILTSCL	Configures the I2C master digital glitch filters for SCL input, a configuration of 0 will disable the glitch filter. Glitches equal to or less than FILTSCL cycles long will be filtered out and ignored. The latency through the glitch filter is equal to FILTSCL cycles and must be configured less than the minimum SCL low or high period.
	The glitch filter cycle count is not affected by the PRESCALE configuration and is automatically bypassed in High Speed mode.
15–12 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
BUSIDLE	Bus Idle Timeout
	Configures the bus idle timeout period in clock cycles. If both SCL and SDA are high for longer than BUSIDLE cycles, then the I2C bus is assumed to be idle and the master can generate a START condition. When set to zero, this feature is disabled.

45.3.10 Master Configuration Register 3 (LPI2Cx_MCFGR3)

The MCFGR3 should only be written when the I2C Master is disabled.

Address: Base address + 2Ch offset



LPI2Cx_MCFGR3 field descriptions

Field	Description
31–20 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
19–8 PINLOW	Pin Low Timeout Configures the pin low timeout flag in clock cycles. If SCL and/or SDA is low for longer than (PINLOW * 256) cycles then PLTF is set. When set to zero, this feature is disabled.
Reserved	This field is reserved. This read-only field is reserved and always has the value 0.

45.3.11 Master Data Match Register (LPI2Cx_MDMR)

Address: Base address + 40h offset



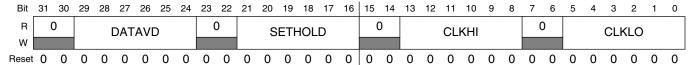
LPI2Cx_MDMR field descriptions

Field	Description
31–24 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
23–16 MATCH1	Match 1 Value Compared against the received data when receive data match is enabled.
15–8 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
MATCH0	Match 0 Value Compared against the received data when receive data match is enabled.

45.3.12 Master Clock Configuration Register 0 (LPI2Cx_MCCR0)

The MCCR0 cannot be changed when the I2C master is enabled and is used for standard, fast, fast-mode plus and ultra-fast transfers.

Address: Base address + 48h offset



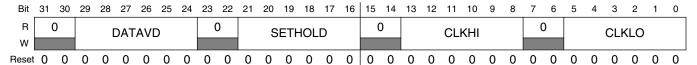
LPI2Cx_MCCR0 field descriptions

Field	Description
31–30 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
29–24 DATAVD	Data Valid Delay Minimum number of cycles (minus one) that is used as the data hold time for SDA. Must be configured less than the minimum SCL low period.
23–22 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
21–16 SETHOLD	Minimum number of cycles (minus one) that is used by the master as the setup and hold time for a (repeated) START condition and setup time for a STOP condition. The setup time is extended by the time it takes to detect a rising edge on the external SCL pin. Ignoring any additional board delay due to external loading, this is equal to (2 + FILTSCL) / 2^PRESCALE cycles.
15–14 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
13–8 CLKHI	Clock High Period Minimum number of cycles (minus one) that the SCL clock is driven high by the master. The SCL high time is extended by the time it takes to detect a rising edge on the external SCL pin. Ignoring any additional board delay due to external loading, this is equal to (2 + FILTSCL) / 2^PRESCALE cycles.
7–6 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
CLKLO	Clock Low Period Minimum number of cycles (minus one) that the SCL clock is driven low by the master. This value is also used for the minimum bus free time between a STOP and a START condition.

45.3.13 Master Clock Configuration Register 1 (LPI2Cx_MCCR1)

The MCCR1 cannot be changed when the I2C master is enabled and is used for high speed mode transfers. The separate clock configuration for high speed mode allows arbitration to take place in Fast mode (with timing configured by MCCR0), before switching to high speed mode (with timing configured by MCCR1).





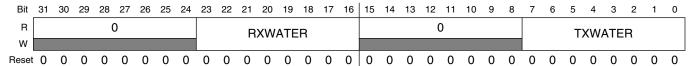
LPI2Cx_MCCR1 field descriptions

Field	Description
31–30 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
29–24 DATAVD	Data Valid Delay Minimum number of cycles (minus one) that is used as the data hold time for SDA. Must be configured less than the minimum SCL low period.
23–22 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
21-16 SETHOLD	Minimum number of cycles (minus one) that is used by the master as the setup and hold time for a (repeated) START condition and setup time for a STOP condition. The setup time is extended by the time it takes to detect a rising edge on the external SCL pin. Ignoring any additional board delay due to external loading, this is equal to (2 + FILTSCL) / 2^PRESCALE cycles.
15–14 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
13–8 CLKHI	Clock High Period Minimum number of cycles (minus one) that the SCL clock is driven high by the master. The SCL high time is extended by the time it takes to detect a rising edge on the external SCL pin. Ignoring any additional board delay due to external loading, this is equal to (2 + FILTSCL) / 2^PRESCALE cycles.
7–6 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
CLKLO	Clock Low Period Minimum number of cycles (minus one) that the SCL clock is driven low by the master. This value is also used for the minimum bus free time between a STOP and a START condition.

1145

45.3.14 Master FIFO Control Register (LPI2Cx_MFCR)

Address: Base address + 58h offset

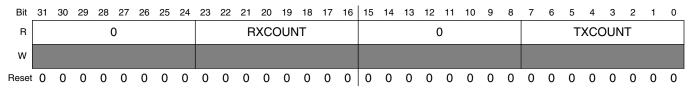


LPI2Cx_MFCR field descriptions

Field	Description
31–24 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
23–16 RXWATER	Receive FIFO Watermark The Receive Data Flag is set whenever the number of words in the receive FIFO is greater than RXWATER. Writing a value equal or greater than the FIFO size will be truncated.
15–8 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
TXWATER	Transmit FIFO Watermark The Transmit Data Flag is set whenever the number of words in the transmit FIFO is equal or less than TXWATER. Writing a value equal or greater than the FIFO size will be truncated.

45.3.15 Master FIFO Status Register (LPI2Cx_MFSR)

Address: Base address + 5Ch offset



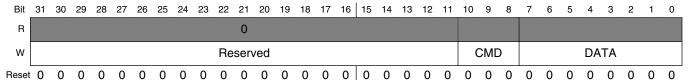
LPI2Cx_MFSR field descriptions

Field	Description
31–24 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
23–16 RXCOUNT	Receive FIFO Count Returns the number of words in the receive FIFO.
15–8 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
TXCOUNT	Transmit FIFO Count Returns the number of words in the transmit FIFO.

45.3.16 Master Transmit Data Register (LPI2Cx_MTDR)

An 8-bit write to the CMD field will store the data in the Command FIFO, but does not increment the FIFO write pointer. An 8-bit write to the DATA field will zero extend the CMD field unless the CMD field has been written separately since the last FIFO write, it also increments the FIFO write pointer. A 16-bit or 32-bit will write both the CMD and DATA fields and increment the FIFO.

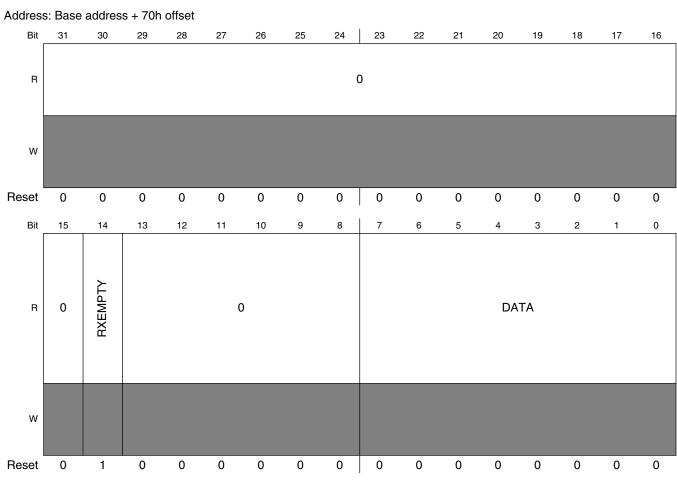




LPI2Cx_MTDR field descriptions

Field	Description
31–11 Reserved	This field is reserved.
10–8 CMD	Command Data
	000 Transmit DATA[7:0].
	001 Receive (DATA[7:0] + 1) bytes.
	010 Generate STOP condition.
	011 Receive and discard (DATA[7:0] + 1) bytes.
	100 Generate (repeated) START and transmit address in DATA[7:0].
	101 Generate (repeated) START and transmit address in DATA[7:0]. This transfer expects a NACK to be returned.
	110 Generate (repeated) START and transmit address in DATA[7:0] using high speed mode.
	111 Generate (repeated) START and transmit address in DATA[7:0] using high speed mode. This transfer expects a NACK to be returned.
DATA	Transmit Data
	Performing an 8-bit write to DATA will zero extend the CMD field.

45.3.17 Master Receive Data Register (LPI2Cx_MRDR)

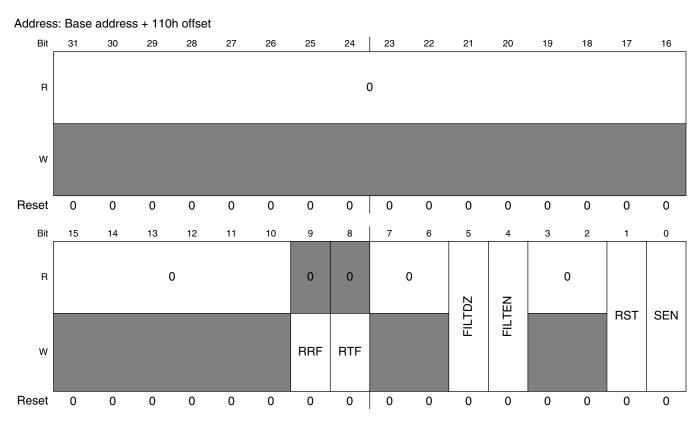


LPI2Cx_MRDR field descriptions

Field	Description
31–15 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
14 RXEMPTY	RX Empty 0 Receive FIFO is not empty. 1 Receive FIFO is empty.
13–8 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
DATA	Receive Data Reading this register returns the data received by the I2C master that has not been discarded. Receive data can be discarded due to the CMD field or the master can be configured to discard non-matching data.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

45.3.18 Slave Control Register (LPI2Cx_SCR)



LPI2Cx_SCR field descriptions

Field	Description
31–10 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
9 RRF	Reset Receive FIFO 0 No effect. 1 Receive Data Register is now empty.
8 RTF	Reset Transmit FIFO 0 No effect. 1 Transmit Data Register is now empty.
7–6 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
5 FILTDZ	Filter Doze Enable 0 Filter remains enabled in Doze mode. 1 Filter is disabled in Doze mode.
4 FILTEN	Filter Enable O Disable digital filter and output delay counter for slave mode. 1 Enable digital filter and output delay counter for slave mode.

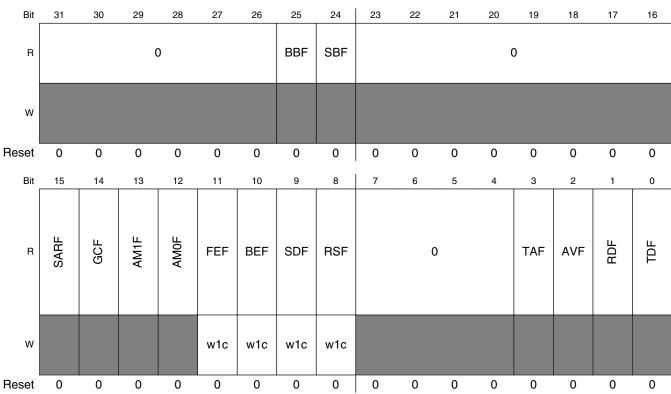
Table continues on the next page...

LPI2Cx_SCR field descriptions (continued)

Field	Description
3–2 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
1 RST	Software Reset O Slave logic is not reset. Slave logic is reset.
0 SEN	Slave Enable O Slave mode is disabled. 1 Slave mode is enabled.

45.3.19 Slave Status Register (LPI2Cx_SSR)





LPI2Cx_SSR field descriptions

Field	Description
31–26 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
25 BBF	Bus Busy Flag

Table continues on the next page...

NXP Semiconductors

1149

Memory Map and Registers

LPI2Cx_SSR field descriptions (continued)

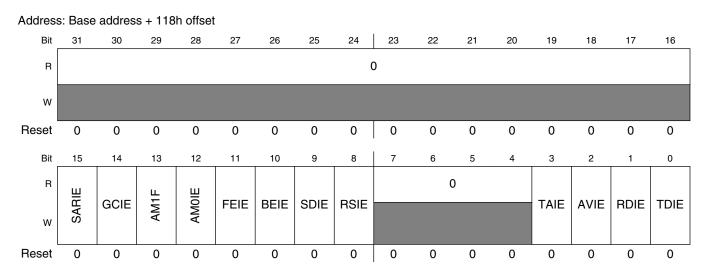
Field	Description
	0 I2C Bus is idle.
	1 I2C Bus is busy.
24 SBF	Slave Busy Flag
JDF	0 I2C Slave is idle.
	1 I2C Slave is busy.
23–16 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
15	SMBus Alert Response Flag
SARF	This flag is cleared by reading the Address Status Register. This flag cannot generate an asynchronous wakeup.
	0 SMBus Alert Response disabled or not detected.
	1 SMBus Alert Response enabled and detected.
14 GCF	General Call Flag
	This flag is cleared by reading the Address Status Register. This flag cannot generate an asynchronous wakeup.
	 Slave has not detected the General Call Address or General Call Address disabled. Slave has detected the General Call Address.
13 AM1F	Address Match 1 Flag
	Indicates that the received address has matched the ADDR1 field or ADDR0 to ADDR1 range as configured by ADDRCFG. This flag is cleared by reading the Address Status Register. This flag cannot generate an asynchronous wakeup.
	0 Have not received ADDR1 or ADDR0/ADDR1 range matching address.
	1 Have received ADDR1 or ADDR0/ADDR1 range matching address.
12 AM0F	Address Match 0 Flag
	Indicates that the received address has matched the ADDR0 field as configured by ADDRCFG. This flag is cleared by reading the Address Status Register. This flag cannot generate an asynchronous wakeup.
	0 Have not received ADDR0 matching address.
	1 Have received ADDR0 matching address.
11 FEF	FIFO Error Flag
	FIFO error flag can only set when clock stretching is disabled.
	FIFO underflow or overflow not detected. FIFO underflow or overflow detected.
10	Bit Error Flag
BEF	This flag will set if the LPI2C slave transmits a logic one and detects a logic zero on the I2C bus. The slave will ignore the rest of the transfer until the next (repeated) START condition.
	0 Slave has not detected a bit error.
	1 Slave has detected a bit error.
L	I

Table continues on the next page...

LPI2Cx_SSR field descriptions (continued)

Field	Description
9 SDF	STOP Detect Flag This flag will set when the LPI2C slave detects a STOP condition, provided the LPI2C slave matched the last address byte. 0 Slave has not detected a STOP condition.
	1 Slave has detected a STOP condition.
8 RSF	Repeated Start Flag This flag will set when the LPI2C slave detects a repeated START condition, provided the LPI2C slave matched the last address byte. It does not set when the slave first detects a START condition. 0 Slave has not detected a Repeated START condition.
	1 Slave has detected a Repeated START condition.
7–4 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
3 TAF	Transmit ACK Flag This flag is cleared by writing the transmit ACK register. Transmit ACK/NACK is not required. Transmit ACK/NACK is required.
2 AVF	Address Valid Flag This flag is cleared by reading the address status register. When RXCFG is set, this flag is also cleared by reading the receive data register. O Address Status Register is not valid. Address Status Register is valid.
1 RDF	Receive Data Flag This flag is cleared by reading the receive data register. When RXCFG is set, this flag is not cleared when reading the receive data register and AVF is set. 0 Receive Data is not ready. 1 Receive data is ready.
0 TDF	Transmit Data Flag This flag is cleared by writing the transmit data register. When TXCFG is clear, it is also cleared if a NACK or Repeated START or STOP condition is detected. Transmit data not requested. Transmit data is requested.

45.3.20 Slave Interrupt Enable Register (LPI2Cx_SIER)



LPI2Cx_SIER field descriptions

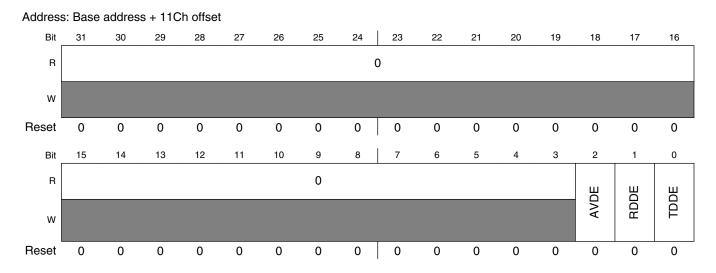
Field	Description
31–16	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
15 SARIE	SMBus Alert Response Interrupt Enable
OAITIE	0 Interrupt disabled.
	1 Interrupt enabled.
14 GCIE	General Call Interrupt Enable
	0 Interrupt disabled.
	1 Interrupt enabled.
13 AM1F	Address Match 1 Interrupt Enable
	0 Interrupt disabled.
	1 Interrupt enabled.
12 AM0IE	Address Match 0 Interrupt Enable
	0 Interrupt enabled.
	1 Interrupt disabled.
11 FEIE	FIFO Error Interrupt Enable
	0 Interrupt disabled.
	1 Interrupt enabled.
10 BEIE	Bit Error Interrupt Enable
	0 Interrupt disabled.
	1 Interrupt enabled.
9 SDIE	STOP Detect Interrupt Enable

Table continues on the next page...

LPI2Cx_SIER field descriptions (continued)

Field	Description
	0 Interrupt disabled.
	1 Interrupt enabled.
8 RSIE	Repeated Start Interrupt Enable
	0 Interrupt disabled.
	1 Interrupt enabled.
7–4	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
3 TAIE	Transmit ACK Interrupt Enable
17412	0 Interrupt disabled.
	1 Interrupt enabled.
2 AVIE	Address Valid Interrupt Enable
	0 Interrupt disabled.
	1 Interrupt enabled.
1 RDIE	Receive Data Interrupt Enable
	0 Interrupt disabled.
	1 Interrupt enabled.
0 TDIE	Transmit Data Interrupt Enable
	0 Interrupt disabled.
	1 Interrupt enabled

45.3.21 Slave DMA Enable Register (LPI2Cx_SDER)

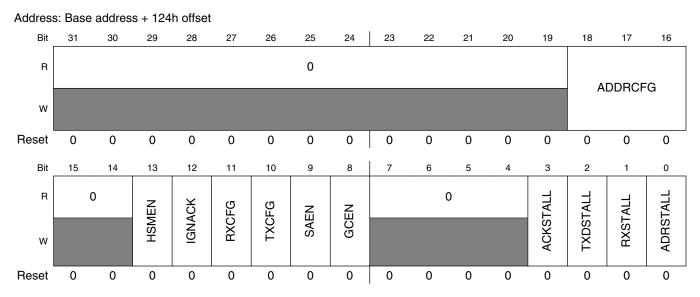


LPI2Cx_SDER field descriptions

Field	Description
31–3	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
2	Address Valid DMA Enable
AVDE	
	The Address Valid DMA request is shared with the Receive Data DMA request. If both are enabled, then
	set RXCFG to allow the DMA to read the address from the Receive Data Register.
	0 DMA request disabled.
	·
	1 DMA request enabled.
1	Receive Data DMA Enable
RDDE	
	0 DMA request disabled.
	1 DMA request enabled.
0	Transmit Data DMA Enable
TDDE	
	0 DMA request disabled.
	1 DMA request enabled

45.3.22 Slave Configuration Register 1 (LPI2Cx_SCFGR1)

The SCFGR1 should only be written when the I2C Slave is disabled.



LPI2Cx_SCFGR1 field descriptions

Field	Description
31–19 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
18–16 ADDRCFG	Address Configuration

Table continues on the next page...

LPI2Cx_SCFGR1 field descriptions (continued)

Field	Description
	Configures the condition that will cause an address to match.
	000 Address match 0 (7-bit).
	001 Address match 0 (7-bit).
	010 Address match 0 (7-bit) or Address match 1 (7-bit).
	011 Address match 0 (10-bit) or Address match 1 (10-bit).
	100 Address match 0 (7-bit) or Address match 1 (10-bit).
	101 Address match 0 (10-bit) or Address match 1 (7-bit).
	110 From Address match 0 (7-bit) to Address match 1 (7-bit).
	111 From Address match 0 (10-bit) to Address match 1 (10-bit).
15–14 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
13 HSMEN	High Speed Mode Enable
	Enables detection of the High-speed Mode master code of slave address 0000_1XX, but does not cause an address match on this code. When set and any Hs-mode master code is detected, the FILTEN and ACKSTALL bits are ignored until the next STOP condition is detected.
	0 Disables detection of Hs-mode master code.
	1 Enables detection of Hs-mode master code.
12 IGNACK	Ignore NACK
	When set, the LPI2C slave will continue transfers after a NACK is detected. This bit is required to be set in Ultra-Fast Mode.
	0 Slave will end transfer when NACK detected.
	1 Slave will not end transfer when NACK detected.
11 RXCFG	Receive Data Configuration
	0 Reading the receive data register will return receive data and clear the receive data flag.
	1 Reading the receive data register when the address valid flag is set will return the address status register and clear the address valid flag. Reading the receive data register when the address valid flag is clear will return receive data and clear the receive data flag.
10	Transmit Flag Configuration
TXCFG	The transmit data flag will always assert before a NACK is detected at the end of a slave-transmit transfer. This can cause an extra word to be written to the transmit data FIFO.
	When TXCFG=0, the transmit data register is automatically emptied when a slave-transmit transfer is detected. This cause the transmit data flag to assert whenever a slave-transmit transfer is detected and negate at the end of the slave-transmit transfer.
	When TXCFG=1, the transmit data flag will assert whenver the transit data register is empty and negate when the transmit data register is full. This allows the transmit data register to be filled before a slave-transmit transfer is detected, but can cause the transmit data register to be written before a NACK is detected on the last byte of a slave transmit transfer.
	0 Transmit Data Flag will only assert during a slave-transmit transfer when the transmit data register is empty.
	1 Transmit Data Flag will assert whenever the transmit data register is empty.
9 SAEN	SMBus Alert Enable

Table continues on the next page...

Memory Map and Registers

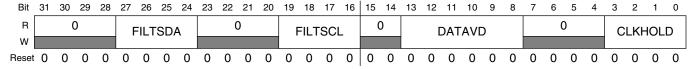
LPI2Cx_SCFGR1 field descriptions (continued)

Field	Description
	0 Disables match on SMBus Alert.
	1 Enables match on SMBus Alert.
8 GCEN	General Call Enable
	0 General Call address is disabled.
	1 General call address is enabled.
7–4 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
3	ACK SCL Stall
ACKSTALL	Enables SCL clock stretching during slave-transmit address byte(s) and slave-receiver address and data byte(s) to allow software to write the Transmit ACK Register before the ACK or NACK is transmitted. Clock stretching occurs when transmitting the 9th bit and is therefore not compatible with high speed mode.
	When ACKSTALL is enabled, there is no need to set either RXSTALL or ADRSTALL
	0 Clock stretching disabled.
	1 Clock stretching enabled.
2 TXDSTALL	TX Data SCL Stall
	Enables SCL clock stretching when the transmit data flag is set during a slave-transmit transfer. Clock stretching occurs following the 9th bit and is therefore compatible with high speed mode.
	0 Clock stretching disabled.
	1 Clock stretching enabled.
1 RXSTALL	RX SCL Stall
-	Enables SCL clock stretching when receive data flag is set during a slave-receive transfer. Clock stretching occurs following the 9th bit and is therefore compatible with high speed mode.
	0 Clock stretching disabled.
	1 Clock stretching enabled.
0 ADRSTALL	Address SCL Stall
	Enables SCL clock stretching when the address valid flag is asserted. Clock stretching only occurs following the 9th bit and is therefore compatible with high speed mode.
	0 Clock stretching disabled.
	1 Clock stretching enabled.

45.3.23 Slave Configuration Register 2 (LPI2Cx_SCFGR2)

The SCFGR2 should only be written when the I2C Slave is disabled.

Address: Base address + 128h offset

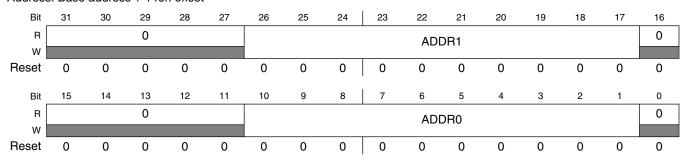


LPI2Cx_SCFGR2 field descriptions

Field	Description
31–28 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
27–24 FILTSDA	Glitch Filter SDA Configures the I2C slave digital glitch filters for SDA input, a configuration of 0 will disable the glitch filter. Glitches equal to or less than FILTSDA cycles long will be filtered out and ignored. The latency through the glitch filter is equal to FILTSDA+3 cycles and must be configured less than the minimum SCL low or high period.
22.22	The glitch filter cycle count is not affected by the PRESCALE configuration, and is disabled in high speed mode.
23–20 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
19–16 FILTSCL	Glitch Filter SCL Configures the I2C slave digital glitch filters for SCL input, a configuration of 0 will disable the glitch filter. Glitches equal to or less than FILTSCL cycles long will be filtered out and ignored. The latency through the glitch filter is equal to FILTSCL+3 cycles and must be configured less than the minimum SCL low or high period.
	The glitch filter cycle count is not affected by the PRESCALE configuration, and is disabled in high speed mode.
15–14 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
13–8 DATAVD	Data Valid Delay Configures the SDA data valid delay time for the I2C slave equal to FILTSCL+DATAVD+3 cycles. This data valid delay must be configured to less than the minimum SCL low period. The I2C slave data valid delay time is not affected by the PRESCALE configuration, and is disabled in high speed mode.
7–4 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
CLKHOLD	Clock Hold Time Configures the minimum clock hold time for the I2C slave, when clock stretching is enabled. The minimum hold time is equal to CLKHOLD+3 cycles. The I2C slave clock hold time is not affected by the PRESCALE configuration, and is disabled in high speed mode.

45.3.24 Slave Address Match Register (LPI2Cx_SAMR)

Address: Base address + 140h offset



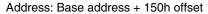
Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

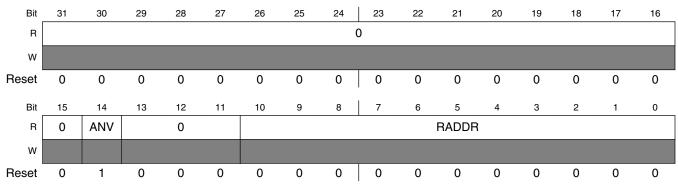
Memory Map and Registers

LPI2Cx_SAMR field descriptions

Field	Description
31–27 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
26–17 ADDR1	Address 1 Value Compared against the received address to detect the Slave Address. In 10-bit mode, the first address byte is compared to { 11110, ADDR1[10:9] } and the second address byte is compared to ADDR1[8:1]. In 7-bit mode, the address is compared to ADDR1[7:1].
16–11 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
10–1 ADDR0	Address 0 Value Compared against the received address to detect the Slave Address. In 10-bit mode, the first address byte is compared to { 11110, ADDR0[10:9] } and the second address byte is compared to ADDR0[8:1]. In 7-bit mode, the address is compared to ADDR0[7:1].
0 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.

45.3.25 Slave Address Status Register (LPI2Cx_SASR)





LPI2Cx_SASR field descriptions

Field	Description
31–15 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
14 ANV	Address Not Valid 0 RADDR is valid. 1 RADDR is not valid.
13–11 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
RADDR	Received Address RADDR updates whenever the AMF is set and the AMF is cleared by reading this register. In 7-bit mode, the address byte is store in RADDR[7:0]. In 10-bit mode, the first address byte is { 11110, RADDR[10:9],

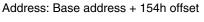
Table continues on the next page...

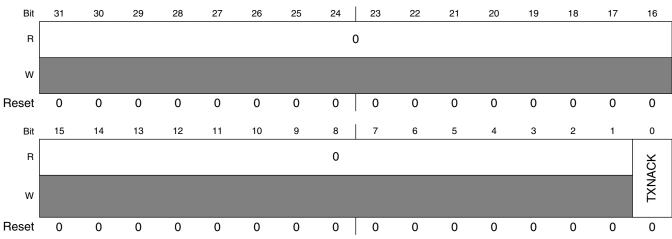
Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

LPI2Cx_SASR field descriptions (continued)

Field	Description
	RADDR[0] } and the second address byte is RADDR[8:1]. The R/W bit is therefore always stored in RADDR[0].

45.3.26 Slave Transmit ACK Register (LPI2Cx_STAR)



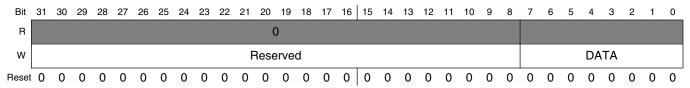


LPI2Cx_STAR field descriptions

Field	Description
31–1 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
0 TXNACK	Transmit NACK When NACKSTALL is set, must be written once for each matching address byte and each received word. Can also be written when LPI2C Slave is disabled or idle to configure the default ACK/NACK.
	0 Transmit ACK for received word.1 Transmit NACK for received word.

45.3.27 Slave Transmit Data Register (LPI2Cx_STDR)

Address: Base address + 160h offset



Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

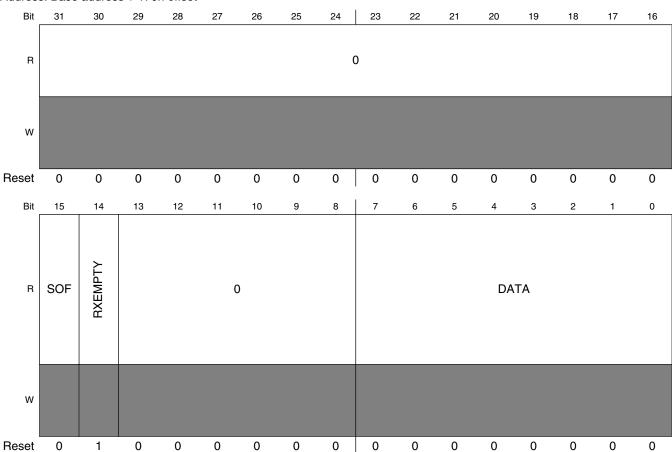
Memory Map and Registers

LPI2Cx_STDR field descriptions

Field	Description
31–8 Reserved	This field is reserved.
DATA	Transmit Data Writing this register will store I2C slave transmit data in the transmit register.

45.3.28 Slave Receive Data Register (LPI2Cx_SRDR)





LPI2Cx_SRDR field descriptions

Field	Description
31–16 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
15 SOF	Start Of Frame O Indicates this is not the first data word since a (repeated) START or STOP condition. Indicates this is the first data word since a (repeated) START or STOP condition.

Table continues on the next page...

LPI2Cx_SRDR field descriptions (continued)

Field	Description
14 RXEMPTY	RX Empty
	0 The Receive Data Register is not empty.
	1 The Receive Data Register is empty.
13–8 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
DATA	Receive Data
	Reading this register returns the data received by the I2C slave.

45.4 Functional description

45.4.1 Clocking and Resets

45.4.1.1 Functional clock

The LPI2C functional clock is asynchronous to the bus clock and can remain enabled in low power modes to support I2C bus transfers by the LPI2C master. It is also used by the LPI2C slave to support digital filter and data hold time configurations. The LPI2C master divides the functional clock by a prescaler and the resulting frequency must be at least eight times faster than the I2C bus bandwidth.

45.4.1.2 External clock

The LPI2C slave logic is clocked directly from the external pins LPI2C_SCL and LPI2C_SDA (or LPI2C_SCLS and LPI2C_SDAS if master and slave are implemented on separate pins). This allows the LPI2C slave to remain operational, even when the LPI2C functional clock is disabled. Note that the LPI2C slave digital filter must be disabled if the LPI2C functional clock is disabled and this can effect compliance with some of the timing parameters of the I2C specification, such as the data hold time.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

45.4.1.3 Bus clock

The bus clock is only used for bus accesses to the control and configuration registers. The bus clock frequency must be sufficient to support the data bandwidth requirements of the LPI2C master and slave registers.

Chip reset 45.4.1.4

The logic and registers for the LPI2C master and slave are reset to their default state on a chip reset.

45.4.1.5 Software reset

The LPI2C master implements a software reset bit in its Control Register. The MCR[RST] will reset all master logic and registers to their default state, except for the MCR itself.

The LPI2C slave implements a software reset bit in its Control Register. The SCR[RST] will reset all slave logic and registers to their default state, except for the SCR itself.

45.4.1.6 FIFO reset

The LPI2C master implements write-only control bits that resets the transmit FIFO (MCR[RTF] and receive FIFO (MCR[RRF]). A FIFO is empty after being reset.

The LPI2C slave implements write-only control bits that resets the transmit data register (SCR[RTF] and receive data register (SCR[RRF]). A data register is empty after being reset.

45.4.2 Master Mode

The LPI2C master logic operates independently from the slave logic to perform all master mode transfers on the I2C bus.

45.4.2.1 Transmit and Command FIFO

The transmit FIFO stores command data to initiate the various I2C operations. The following operations can be initiated through commands in the transmit FIFO:

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018 1162 NXP Semiconductors

- START or Repeated START condition with address byte and expecting ACK or NACK.
- Transmit data (this is the default for zero extended byte writes to the transmit FIFO).
- Receive 1-256 bytes of data (can also be configured to discard receive data and not store in receive FIFO).
- STOP condition (can also be configured to send STOP condition when transmit FIFO is empty).

Multiple transmit and receive commands can be inserted between the START condition and STOP condition, transmit and receive commands must not be interleaved in order to comply with the I2C specification. The receive data command and the receive data and discard command can be interleaved to ensure only the desired received data is stored in the receive FIFO (or compared with the data match logic).

The LPI2C master supports 10-bit addressing through a (repeated) START condition, followed by a transmit byte with the second address byte, followed by any number of data bytes with the master-transmit data.

A START or Repeated START condition that is expecting a NACK (for example, hsmode master code) must be followed by a STOP or (repeated) START condition.

Master Operation 45.4.2.2

Whenever the LPI2C is enabled, it monitors the I2C bus to detect when the I2C bus is idle (MSR[BBF]). The I2C bus is no longer considered idle if either SCL or SDA are low and becomes idle if a STOP condition is detected or if a bus idle timeout is detected (as configured by MCFGR2[BUSIDLE]). Once the I2C bus is idle, the transmit FIFO is not empty, and the host request is either asserted or disabled, then the LPI2C master will initiate a transfer on the I2C bus. This involves the following steps:

- Wait the bus idle time equal to (MCCR0[CLKLO] + 1) multiplied by the prescaler.
- Transmit a START condition and address byte using the timing configuration in MCCR0, if a high speed mode transfer is configured then timing configuration from MCCR1 is used instead.
- Perform master-transmit or master-receive transfers, as configured by the transmit FIFO.
- Transmit a Repeated START or STOP condition as configured by the transmit FIFO and/or MCFGR1[AUTOSTOP]. A repeated START can change which timing configuration register is used.

Functional description

When the LPI2C master is disabled (either due to MCR[MEN] being clear or automatically due to mode entry), the LPI2C will continue to empty the transmit FIFO until a STOP condition is transmitted. However, it will no longer stall the I2C bus waiting for the transmit or receive FIFO and once the transmit FIFO is empty it will generate a STOP condition automatically.

The LPI2C master can stall the I2C bus under certain conditions, this will result in SCL pulled low continuously on the first bit of a byte until the condition is removed:

- LPI2C master is enabled and busy, transmit FIFO is empty, and MCFGR1[AUTOSTOP] is clear.
- LPI2C master is enabled and receiving data, receive data is not being discarded (due to command or receive data match), and receive FIFO is full.

45.4.2.3 Receive FIFO and Data Match

The receive FIFO is used to store receive data during master-receiver transfers. Receive data can also be configured to discard receive data instead of storing in the receive FIFO, this is configured by the command word in the transmit FIFO.

Receive data supports a receive data match function that can match received data against one of two bytes or against a masked data byte. The data match function can also be configured to compare only the first one or two received data words since the last (repeated) START condition. Receive data that is already discarded due to the command word cannot cause the data match to set and will delay the match on first received data word until after the discarded data is received. The receiver match function can also be configured to discard all receive data until a data match is detected, using the MCFGR0[RDMO] control bit. When clearing the MCFGR0[RDMO] control bit following a data match, clear MCFGR0[RDMO] before clearing MSR[DMF] to allow all subsequent data to be received.

45.4.2.4 Timing Parameters

The following timing parameters can be configured by the LPI2C master. Parameters are configured separately for high speed mode (MCCR1) and other modes (MCCR0). This allows the high speed mode master code to be sent using the regular timing parameters and then switch to the high speed mode timing (following a repeated START) until the next STOP condition.

The LPI2C master timing parameters in LPI2C functional clock cycles are configured as follows. They must be configured to meet the I2C timing specification for the required mode.

- Bus idle time is always (MCCR0[CLKLO] + 1) multiplied by the prescaler. This is extended by the time it takes to detect external SDA rising edge.
- START or repeated START hold time is equal to (MCCR0/1[SETHOLD] + 1) multiplied by the prescaler.
- START, or repeated START, or STOP setup time is equal to (MCCR0/1[SETHOLD] + 1) multiplied by the prescaler. This is extended by the time it takes to detect external SCL rising edge.
- SCL low time (before clock stretching) is equal to (MCCR0/1[CLKLO] + 1) multiplied by the prescaler.
- SCL high time is equal to (MCCR0/1[CLKHI] + 1) multiplied by the prescaler. This is extended by the time it takes to detect external SCL rising edge.
- SDA output delay is equal to (MCCR0/1[DATAVD] + 1) multiplied by the prescaler.

The time taken to detect an external rising edge depends on a number of factors including the bus loading and external pull-up resistor sizing. The minimum delay equals two plus the pin input digital filter setting (which are configured separately for SCL and SDA), divided by the prescaler (since the pin input digital filters are not affected by the prescaler setting).

The following timing restrictions must be enforced to avoid unexpected START or STOP conditions on the I2C bus or unexpected START or STOP conditions detected by the LPI2C master. They can be summarized as SDA cannot change when SCL is high outside of a transmitted (repeated) START or STOP condition.

Timing Parameter Minimum Maximum Comment **CLKLO** 0x03 CLKLO must also be greater than delay through the SCL filter. **CLKHI** 0x01 **SETHOLD** 0x02 DATAVD CLKLO - [(FILTSDA+2) / (2 ^ 0x01 DATAVD must be less than PRESCALER)] CLKLO minus delay through the SDA filter. **FILTSCL** [CLKLO × (2 ^ PRESCALER)] 0x00 - 3 **FILTSDA** [CLKLO × (2 ^ PRESCALER)] **FILTSCL** Does not apply if - 3 compensating for board level skew between SCL and SDA. BUSIDLE (CLKLO+SETHOLD+2) × 2 Must also be greater than CLKHI+1.

Table 45-3. Timing Parameters

Functional description

The timing parameters must be configured to meet the requirements of the I2C specification, this will depend on the mode being supported, the frequency of the LPI2C functional clock. Some example configurations are provided below.

SETHOLD Baud Rate PRESCAL FILTSCL/ **CLKLO CLKHI I2C Mode** Clock **DATAVD** Frequency **ER FILTSDA** Fast 8 MHz 400 kbps 0x0 0x0/0x00x04 0x0B 0x05 0x02 Fast+ 8 MHz 1 Mbps 0x0/0x00x02 0x03 0x01 0x01 0x0 Fast 48 MHz 400 kbps 0x2 0x1/0x1 0x07 0x11 0x0B 0x03 Fast+ 48 MHz 1 Mbps 0x2 0x1/0x10x03 0x06 0x04 0x04 Fast+ 48 MHz 1 Mbps 0x0 0x1/0x10x1D 0x18 0x13 0x0F HS-mode 48 MHz 3.2 Mbps 0x0 0x0/0x00x07 80x0 0x03 0x01 Fast 60 MHz 400 kbps 0x1 0x2/0x2 0x11 0x28 0x21 80x0 Fast+ 60 MHz 1 Mbps 0x1 0x2/0x2 0x07 0x0F 0x0B 0x01 HS-mode 60 MHz 3.33 Mbps 0x1 0x0/0x00x04 0x03 0x04 0x01 Ultrafast 60 MHz 5 Mbps 0x0 0x0/0x00x02 0x05 0x03 0x01

Table 45-4. LPI2C Example Timing Configurations

The formula to calculate number of cycles per bit is as follows:

 $Baud\ rate\ divide = ((CLKLO + CLKHI + 2)*2^PRESCALER) + ROUNDDOWN((2+FILTSCL)/2^PRESCALER)$

This assumes SCL will pull high within 1 cycle of the LPI2C functional clock, this will depend on the pullup resistor and loading on the SCL pin.

45.4.2.5 Error Conditions

The LPI2C master will monitor for errors while it is active, the following conditions will generate an error flag and block a new START condition from being sent until the flag is cleared by software:

- START or STOP condition detected and not generated by LPI2C master (sets MSR[ALF]).
- Transmitting data on SDA and different value being received (sets MSR[ALF]).
- NACK detected when transmitting data, provided MCFGR1[IGNACK] is clear (sets MSR[NDF]).
- NACK detected and expecting ACK for address byte, provided MCFGR1[IGNACK] is clear (sets MSR[NDF]).
- ACK detected and expecting NACK for address byte, provided MCFGR1[IGNACK] is clear (sets MSR[NDF]).

- Transmit FIFO requesting to transmit or receive data without a START condition (sets MSR[FEF]).
- SCL (or SDA if MCFGR1[TIMECFG] is set) is low for (MCFGR2[TIMELOW] * 256) prescaler cycles without a pin transition (sets MSR[PLTF]).

Software must respond to the MSR[PTLF] flag to terminate the existing command either cleanly (by clearing MCR[MEN]) or abruptly (by setting MCR[SWRST]).

The MCFGR2[BUSIDLE] field can be used to force the I2C bus to be considered idle when SCL and SDA remain high for (BUSIDLE+1) prescaler cycles. The I2C bus is normally considered idle when the LPI2C master is first enabled, but when BUSIDLE is configured greater than zero then SCL and/or SDA must be high for (BUSIDLE+1) prescaler cycles before the I2C bus is first considered idle.

45.4.2.6 Pin Configuration

The LPI2C master defaults to open-drain configuration of the LPI2C_SDA and LPI2C_SCL pins. Support for true open drain is device specific and requires the pins where LPI2C pins are muxed to support true open drain. Support for high speed mode is also device specific and requires the LPI2C_SCL pin to support the current source pull-up required in the I2C specification.

The LPI2C master also supports the output only push-pull function required for I2C ultra-fast mode using the LPI2C_SDA and LPI2C_SCL pins. Support for ultra-fast mode also requires the IGNACK bit to be set.

A push-pull 2 wire configuration is also available to the LPI2C master that may support a partial high speed mode provided the LPI2C is the only master and all I2C pins on the bus are at the same voltage. This will configure the LPI2C_SCL pin as push-pull for every clock except the 9th clock pulse to allow high speed mode compatible slaves to perform clock stretching. In this mode, the LPI2C_SDA pin is tristated for master-receive data bits and master-transmit ACK/NACK bits.

The push-pull 4 wire configuration separates the SCL input and output and the SDA input and output onto separate pins, with SCL/SDA used as the input pins and SCLS/SDAS used as the output pins with configurable polarity. This simplifies the external connections when connecting the I2C bus to external level shifters. The LPI2C master logic and LPI2C slave logic are not able to connect to separate I2C buses when using this configuration.

Functional description

45.4.3 Slave Mode

The LPI2C slave logic operates independently from the master logic to perform all slave mode transfers on the I2C bus.

45.4.3.1 Address Match

The LPI2C slave can be configured to match one of two addresses using either 7-bit or 10-bit addressing modes for each address, or to match a range of addresses in either 7-bit or 10-bit addressing modes. Separately, it can be configured to match the General Call Address or the SMBus Alert Address and generate appropriate flags. The LPI2C slave can also be configured to detect the high speed mode master code and to disable the digital filters and output valid delay time until the next STOP condition is detected.

Once a valid address is matched, the LPI2C slave will automatically perform slave-transmit or slave-receive transfers until a NACK is detected (unless IGNACK is set), a bit error is detected (the LPI2C slave is driving SDA, but a different value is sampled), or a (repeated) START or STOP condition is detected.

45.4.3.2 Transmit and Receive

The transmit and receive data registers are double buffered and only update during a slave-transmit and slave-receive transfer respectively. The slave address that was received can be configured to be read from either the receive data register (for example, when using DMA to transfer data) or from the address status register. The transmit data register can be configured to only request data once a slave-transmit transfer is detected or to request new data whenever the transmit data register is empty.

The transmit data register should only be written when the transmit data flag is set. The receive data register should only be read when the received data flag is set (or the address valid flag is set and RXCFG=1). The address status register should only be read when the address valid flag is set.

45.4.3.3 Clock Stretching

The LPI2C slave supports many configurable options for when clock stretching is performed. The following conditions can be configured to perform clock stretching.

- During 9th clock pulse of address byte and address valid flag is set.
- During 9th clock pulse of slave-transmit transfer and transmit data flag is set.
- During 9th clock pulse of slave-receive transfer and receive data flag is set.

- During 8th clock pulse of address byte or slave-receive transfer and transmit ACK flag is set. This is disabled in high speed mode.
- Clock stretching can also be extended for CLKHOLD cycles to allow additional setup time to sample the SDA pin externally. This is disabled in high speed mode.

Unless extended by the CLKHOLD configuration, clock stretching will extend for one peripheral bus clock cycle after SDA updates when clock stretching is enabled.

45.4.3.4 Timing Parameters

The LPI2C slave can configure the following timing parameters, these parameters are disabled when SCR[FILTEN] is clear, when SCR[FILTDZ] is set in Doze mode, and when LPI2C slave detects high speed mode. When disabled, the LPI2C slave is clocked directly from the I2C bus and may not satisfy all timing requirements of the I2C specification (such as SDA minimum hold time in Standard/Fast mode).

- SDA data valid time from SCL negation to SDA update.
- SCL hold time when clock stretching is enabled to increase setup time when sampling SDA externally.
- SCL glitch filter time.
- SDA glitch filter time.

The LPI2C slave imposes the following restrictions on the timing parameters.

- FILTSDA must be configured to greater than or equal to FILTSCL (unless compensating for board level skew between SDA and SCL).
- DATAVD must be configured less than the minimum SCL low period.

45.4.3.5 Error Conditions

The LPI2C slave can detect the following error conditions.

- Bit error flag will set when the LPI2C slave is driving SDA, but samples a different value than what is expected.
- FIFO error flag will set due to a transmit data underrun or a receive data overrun. Clock stretching can be enabled to eliminate the possibility of underrun and overrun occurring.
- FIFO error flag will also set due to an address overrun when RXCFG is set, otherwise an address overrun is not flagged. Clock stretching can be enabled to eliminate the possibility of overrun occurring.

Functional description

The LPI2C slave does not implement a timeout due to SCL and/or SDA being stuck low. If this detection is required, the LPI2C master logic should be used and software can reset the LPI2C slave when this condition is detected.

45.4.4 Interrupts and DMA Requests

The LPI2C master and slave interrupts may be combined depending on the device.

The LPI2C master and slave transmit DMA requests may be combined depending on the device.

The LPI2C master and slave receive DMA requests may be combined depending on the device.

45.4.4.1 Master mode

The following table illustrates the master mode sources that can generate the LPI2C master interrupt and LPI2C master transmit/receive DMA requests.

Table 45-5. Master Interrupts and DMA Requests

Flag	Description	Interrupt	DMA Request	Low Power Wakeup
TDF	Data can be written to transmit FIFO, as configured by TXWATER.	Y	ТХ	Y
RDF	Data can be read from the receive FIFO, as configured by RXWATER.	Y	RX	Y
EPF	Master has transmitted Repeated START or STOP condition.	Y	N	Y
SDF	Master has transmitted STOP condition.	Y	N	Y
NDF	Master detected NACK during address byte when expecting ACK, master detected ACK during address byte and expecting NACK, or master detected NACK during mastertransmitter data byte.	Υ	N	Y
ALF	Master lost arbitration due to START/STOP condition detected at	Y	N	Y

Table continues on the next page...

Table 45-5. Master Interrupts and DMA Requests (continued)

Flag	Description	Interrupt	DMA Request	Low Power Wakeup
	wrong time, or Master was transmitting data but received different data than what was transmitted.			
FEF	Master expecting START condition in command FIFO and next entry in FIFO is not START condition.	Y	N	Y
PLTF	Pin low timeout is enabled and SCL (or SDA if configured) is low for longer than the configured timeout.	Y	N	Y
DMF	Received data matches the configured data match, and receive data not discarded due to command FIFO entry.	Y	N	Y
MBF	LPI2C master is busy transmitting/receiving data.	N	N	N
BBF	LPI2C master is enabled and activity detected on I2C bus, but STOP condition has not been detected and bus idle timeout (if enabled) has not occurred.	N	N	N

45.4.4.2 Slave mode

The following table illustrates the slave mode sources that can generate the LPI2C slave interrupt and the LPI2C slave transmit/receive DMA requests.

Table 45-6. Slave Interrupts and DMA Requests

Flag	Description	Interrupt	DMA Request	Low Power Wakeup
TDF	Data can be written to transmit data register.	Υ	TX	Y
RDF	Data can be read from the receive data register.	Υ	RX	Υ

Table continues on the next page...

Functional description

Table 45-6. Slave Interrupts and DMA Requests (continued)

Flag	Description	Interrupt	DMA Request	Low Power Wakeup
AVF	Address can be read from the address status register.	Y	RX	Y
TAF	ACK/NACK can be written to the transmit ACK register.	Υ	N	Y
RSF	Slave has detected an address match followed by a Repeated START condition.	Υ	N	Y
SDF	Slave has detected an address match followed by a STOP condition.	Y	N	Y
BEF	Slave was transmitting data, but received different data than what was transmitted.	Y	N	Y
FEF	Transmit data underrun, receive data overrun or address status overrun (when RXCFG=1). This flag can only set when clock stretching is disabled.	Y	N	Y
AMOF	Slave detected address match with ADDR0 field.	Y	N	N
AM1F	Slave detected address match with ADDR1 field or address range.	Y	N	N
GCF	Slave detected address match with general call address.	Y	N	N
SARF	Slave detected address match with SMBus alert address.	Y	N	N
SBF	LPI2C slave is busy receiving address byte or transmitting/receiving data.	N	N	N
BBF	LPI2C slave is enabled and START condition detected on I2C bus, but STOP condition has not been detected.	N	N	N

45.4.5 Peripheral Triggers

The connection of the LPI2C peripheral triggers with other peripherals are device specific.

45.4.5.1 Master Output Trigger

The LPI2C master generates an output trigger that can be connected to other peripherals on the device. The master output trigger asserts on both a Repeated START or STOP condition and remains asserted for one cycle of the LPI2C functional clock divided by the prescaler.

45.4.5.2 Slave Output Trigger

The LPI2C slave generates an output trigger that can be connected to other peripherals on the device. The slave output trigger asserts on both a Repeated START or STOP condition that occurs following a slave address match. It remains asserted until the next slave SCL pin negation.

45.4.5.3 Input Trigger

The LPI2C input trigger can be selected in place of the LPI2C_HREQ pin to control the start of a LPI2C master bus transfer. The input trigger must assert for longer than one LPI2C functional clock cycle to be detected.

45.5 Usage Guide

For master:

- Configure functional clock source by SIM_SOPT2[LPI2C0SRC]
- Reset LPI2C module by LPI2C0_MCR[RST]
- Configure baudrate
- Set Tx/Rx FIFO watermark by LPI2C0_MFCR
- Enable Master mode by set LPI2C0_MCR[MEN]

For slave:

- Configure functional clock source by SIM_SOPT2[LPI2C0SRC]
- Set the slave address into LPI2C0_SAMR
- Configure the TDF only be set in the Slave-Transmit condition by LPI2C0_SCFGR1[TXCFG]

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Usage Guide

- Enable the TX Data SCL Stall and RX SCL Stall for clock stretching on SCL
- Enable Slave mode by set LPI2C0_SCR[SEN]

Chapter 46 Low Power Universal Asynchronous Receiver/ Transmitter (LPUART)

46.1 Chip-specific information for this module

46.1.1 Instantiation Information

This device has three LPUART modules. The LPUART can remain functional in Stop and VLPS mode provided the clock it is using remains enabled.

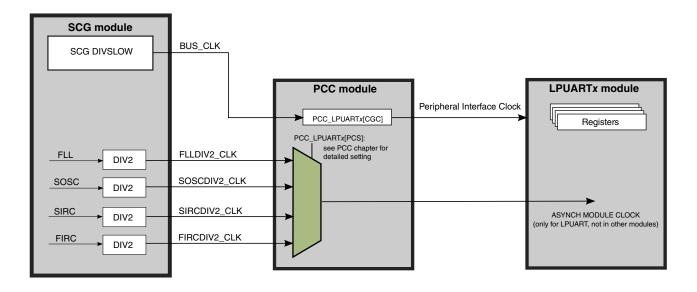
Table 46-1. LPUART Configuration

	TX FIFO (word/10bit)	RX FIFO (word/10bit)	Single-wire mode
LPUART0	4	4	Yes
LPUART1	4	4	Yes
LPUART2	4	4	Yes

46.1.2 Module Clocking Information for LPUART, LPSPI, LPI2C, FlexIO and LPIT

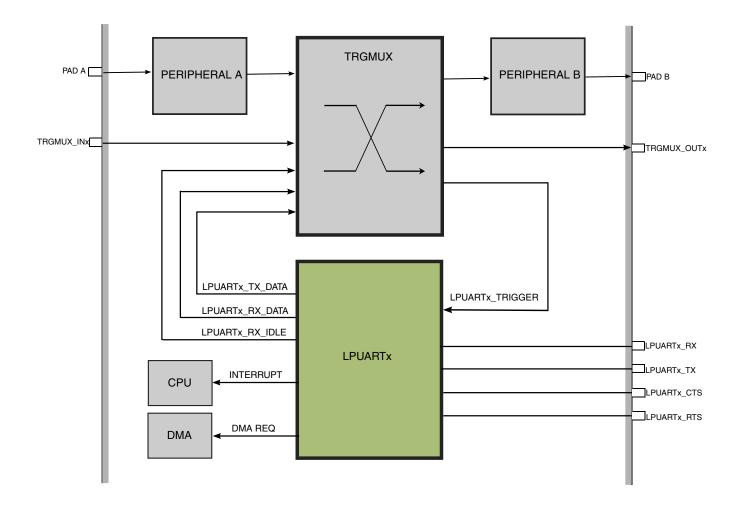
The following figure shows the input clock sources available for this module.

Peripheral Clocking - LPUART Note: this example figure also applies similarly to the clocking for LPSPI, LPI2C, and LPIT.



46.1.3 Inter-connectivity Information

The LPUART inter-connectivity is shown in following diagram.



46.2 Introduction

46.2.1 Features

Features of the LPUART module include:

- Full-duplex, standard non-return-to-zero (NRZ) format
- Programmable baud rates (13-bit modulo divider) with configurable oversampling ratio from 4x to 32x
- Transmit and receive baud rate can operate asynchronous to the bus clock:
 - Baud rate can be configured independently of the bus clock frequency
 - Supports operation in Stop modes
- Interrupt, DMA or polled operation:
 - Transmit data register empty and transmission complete

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Introduction

- Receive data register full
- Receive overrun, parity error, framing error, and noise error
- Idle receiver detect
- Active edge on receive pin
- Break detect supporting LIN
- Receive data match
- Hardware parity generation and checking
- Programmable 7-bit, 8-bit, 9-bit or 10-bit character length
- Programmable 1-bit or 2-bit stop bits
- Three receiver wakeup methods:
 - Idle line wakeup
 - Address mark wakeup
 - Receive data match
- Automatic address matching to reduce ISR overhead:
 - Address mark matching
 - Idle line address matching
 - Address match start, address match end
- Optional 13-bit break character generation / 11-bit break character detection
- Configurable idle length detection supporting 1, 2, 4, 8, 16, 32, 64 or 128 idle characters
- Selectable transmitter output and receiver input polarity
- Hardware flow control support for request to send (RTS) and clear to send (CTS) signals
- Selectable IrDA 1.4 return-to-zero-inverted (RZI) format with programmable pulse width
- Independent FIFO structure for transmit and receive
 - Separate configurable watermark for receive and transmit requests
 - Option for receiver to assert request after a configurable number of idle characters if receive FIFO is not empty

46.2.2 Modes of operation

46.2.2.1 Stop mode

The LPUART will remain functional during Stop mode, provided the asynchronous transmit and receive clock remains enabled. The LPUART can generate an interrupt or DMA request to cause a wakeup from Stop mode.

46.2.2.2 Wait mode

The LPUART can be configured to Stop in Wait modes, when the DOZEEN bit is set. The transmitter and receiver will finish transmitting/receiving the current word.

46.2.2.3 Debug mode

The LPUART remains functional in debug mode.

46.2.3 Signal Descriptions

Signal	Description	I/O
TXD	Transmit data. This pin is normally an output, but is an input (tristated) in single wire mode whenever the transmitter is disabled or transmit direction is configured for receive data.	I/O
RXD	Receive data.	I
CTS_B	Clear to send.	I
RTS_B	Request to send.	0

46.2.4 Block diagram

The following figure shows the transmitter portion of the LPUART.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

1179

Introduction

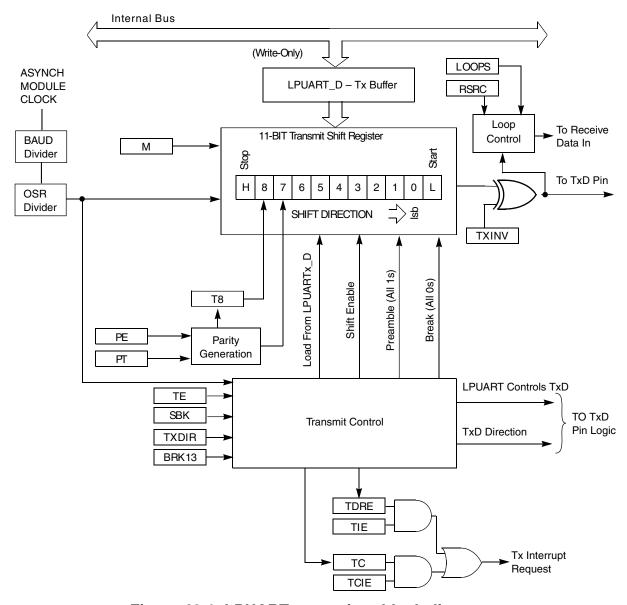


Figure 46-1. LPUART transmitter block diagram

The following figure shows the receiver portion of the LPUART.

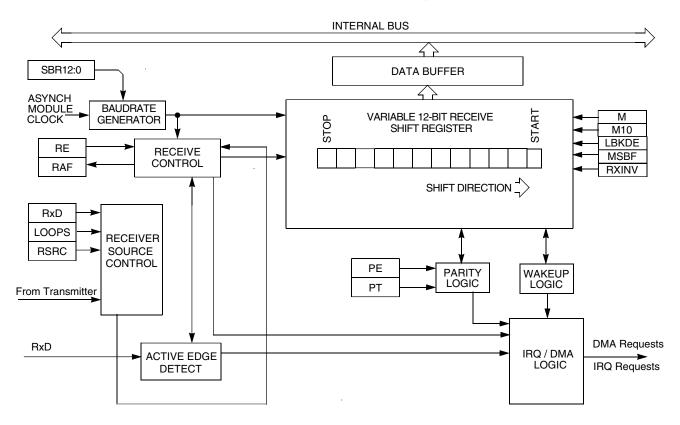


Figure 46-2. LPUART receiver block diagram

46.3 Register definition

The LPUART includes registers to control baud rate, select LPUART options, report LPUART status, and for transmit/receive data. Access to an address outside the valid memory map will generate a bus error.

46.3.1 LPUART Register Descriptions

These registers may not be applicable to all instances of LPUART. For more details on the registers supported on each module instance, please refer to "The LPUART as implemented on the chip."

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

1181

46.3.1.1 LPUART Memory Map

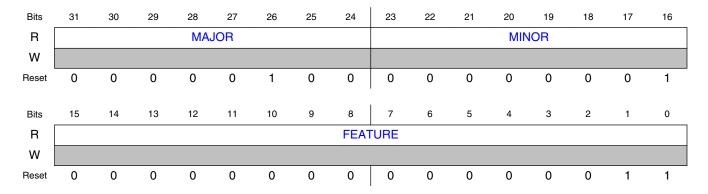
Absolute	Register	Width	Access	Reset value
address		(In bits)		
4006A000h	Version ID (LPUART0_VERID)	32	RO	04010003h
4006A004h	Parameter (LPUART0_PARAM)	32	RO	00000202h
4006A008h	LPUART Global (LPUART0_GLOBAL)	32	RW	00000000h
4006A00Ch	LPUART Pin Configuration (LPUART0_PINCFG)	32	RW	00000000h
4006A010h	LPUART Baud Rate (LPUART0_BAUD)	32	RW	0F000004h
4006A014h	LPUART Status (LPUART0_STAT)	32	RW	00C00000h
4006A018h	LPUART Control (LPUART0_CTRL)	32	RW	00000000h
4006A01Ch	LPUART Data (LPUART0_DATA)	32	RW	00001000h
4006A020h	LPUART Match Address (LPUART0_MATCH)	32	RW	00000000h
4006A024h	LPUART Modem IrDA (LPUART0_MODIR)	32	RW	00000000h
4006A028h	LPUART FIFO (LPUARTO_FIFO)	32	RW	00C00011h
4006A02Ch	LPUART Watermark (LPUART0_WATER)	32	RW	00000000h
4006B000h	Version ID (LPUART1_VERID)	32	RO	04010003h
4006B004h	Parameter (LPUART1_PARAM)	32	RO	00000202h
4006B008h	LPUART Global (LPUART1_GLOBAL)	32	RW	00000000h
4006B00Ch	LPUART Pin Configuration (LPUART1_PINCFG)	32	RW	00000000h
4006B010h	LPUART Baud Rate (LPUART1_BAUD)	32	RW	0F000004h
4006B014h	LPUART Status (LPUART1_STAT)	32	RW	00C00000h
4006B018h	LPUART Control (LPUART1_CTRL)	32	RW	00000000h
4006B01Ch	LPUART Data (LPUART1_DATA)	32	RW	00001000h
4006B020h	LPUART Match Address (LPUART1_MATCH)	32	RW	00000000h
4006B024h	LPUART Modem IrDA (LPUART1_MODIR)	32	RW	00000000h
4006B028h	LPUART FIFO (LPUART1_FIFO)	32	RW	00C00011h
4006B02Ch	LPUART Watermark (LPUART1_WATER)	32	RW	00000000h
4006C000h	Version ID (LPUART2_VERID)	32	RO	04010003h
4006C004h	Parameter (LPUART2_PARAM)	32	RO	00000202h
4006C008h	LPUART Global (LPUART2_GLOBAL)	32	RW	00000000h
4006C00Ch	LPUART Pin Configuration (LPUART2_PINCFG)	32	RW	00000000h
4006C010h	LPUART Baud Rate (LPUART2_BAUD)	32	RW	0F000004h
4006C014h	LPUART Status (LPUART2_STAT)	32	RW	00C00000h
4006C018h	LPUART Control (LPUART2_CTRL)	32	RW	00000000h
4006C01Ch	LPUART Data (LPUART2_DATA)	32	RW	00001000h
4006C020h	LPUART Match Address (LPUART2_MATCH)	32	RW	00000000h
4006C024h	LPUART Modem IrDA (LPUART2_MODIR)	32	RW	00000000h
4006C028h	LPUART FIFO (LPUART2_FIFO)	32	RW	00C00011h
4006C02Ch	LPUART Watermark (LPUART2_WATER)	32	RW	00000000h

46.3.1.2 Version ID (VERID)

46.3.1.2.1 Address

Register	Offset
VERID	Base address + 0h offset

46.3.1.2.2 Diagram



46.3.1.2.3 Fields

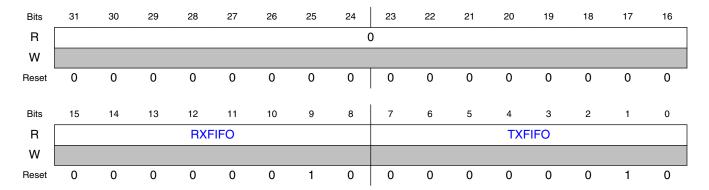
Field	Function
31-24	Major Version Number
MAJOR	This read only field returns the major version number for the module specification.
23-16	Minor Version Number
MINOR	This read only field returns the minor version number for the module specification.
15-0	Feature Identification Number
FEATURE	This read only field returns the feature set number. 000000000000001 - Standard feature set. 000000000000011 - Standard feature set with MODEM/IrDA support.

46.3.1.3 Parameter (PARAM)

46.3.1.3.1 Address

Register	Offset
PARAM	Base address + 4h offset

46.3.1.3.2 Diagram



46.3.1.3.3 Fields

Field	Function
31-16	Reserved
_	
15-8	Receive FIFO Size
RXFIFO	The number of words in the receive FIFO is 2^RXFIFO.
7-0	Transmit FIFO Size
TXFIFO	The number of words in the transmit FIFO is 2^TXFIFO.

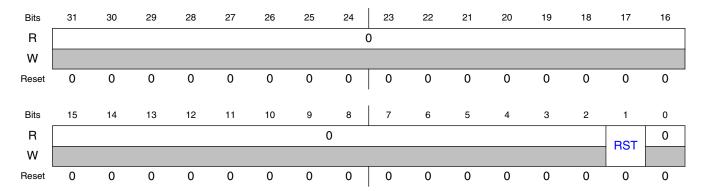
46.3.1.4 LPUART Global (GLOBAL)

46.3.1.4.1 Address

Register	Offset
GLOBAL	Base address + 8h offset

1184 NXP Semiconductors

46.3.1.4.2 Diagram



46.3.1.4.3 Fields

Field	Function
31-2	Reserved
_	
1	Software Reset
RST	Reset all internal logic and registers, except the Global Register. Remains set until cleared by software. 0 - Module is not reset. 1 - Module is reset.
0	Reserved
_	

46.3.1.5 LPUART Pin Configuration (PINCFG)

46.3.1.5.1 Address

Register	Offset
PINCFG	Base address + Ch offset

1185

Register definition

46.3.1.5.2 Diagram

Bits	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
R								(0							
W																
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Bits	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
R							(0	•						TRG	· CEI
W															THG	ISEL
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

46.3.1.5.3 Fields

Field	Function
31-2	Reserved
_	
1-0	Trigger Select
TRGSEL	Configures the input trigger usage. 00 - Input trigger is disabled. 01 - Input trigger is used instead of RXD pin input. 10 - Input trigger is used instead of CTS_B pin input. 11 - Input trigger is used to modulate the TXD pin output.

46.3.1.6 LPUART Baud Rate (BAUD)

46.3.1.6.1 Address

Register	Offset
BAUD	Base address + 10h offset

46.3.1.6.2 Diagram

Bits	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
R	MAE	MAE							TDM	0	RDM	RIDM			вотн	
W	N1	N2	M10			OSR			AE		AE	AE	MAI	CFG	EDG E	NCDI S
Reset	0	0	0	0	1	1	1	1	0	0	0	0	0	0	0	0
Bits	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
R W	LBKD IE	RXED GIE	SBNS							SBR						
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0

46.3.1.6.3 Fields

Field	Function
31	Match Address Mode Enable 1
MAEN1	O - Normal operation. 1 - Enables automatic address matching or data matching mode for MATCH[MA1].
30	Match Address Mode Enable 2
MAEN2	O - Normal operation. 1 - Enables automatic address matching or data matching mode for MATCH[MA2].
29	10-bit Mode select
M10	The M10 bit causes a tenth bit to be part of the serial transmission. This bit should only be changed when the transmitter and receiver are both disabled. 0 - Receiver and transmitter use 7-bit to 9-bit data characters. 1 - Receiver and transmitter use 10-bit data characters.
28-24	Oversampling Ratio
OSR	This field configures the oversampling ratio for the receiver between 4x (00011) and 32x (11111). Writing an invalid oversampling ratio (i.e., a value not between 4x and 32x) will default to an oversampling ratio of 16 (01111). This field should only be changed when the transmitter and receiver are both disabled.
23	Transmitter DMA Enable
TDMAE	TDMAE configures the transmit data register empty flag, LPUART_STAT[TDRE], to generate a DMA request. 0 - DMA request disabled. 1 - DMA request enabled.
22	Reserved
_	
21	Receiver Full DMA Enable
RDMAE	RDMAE configures the receiver data register full flag, LPUART_STAT[RDRF], to generate a DMA request. 0 - DMA request disabled. 1 - DMA request enabled.
20	Receiver Idle DMA Enable
RIDMAE	

Table continues on the next page...

Register definition

Field	Function
	RIDMAE configures the receiver idle flag, LPUART_STAT[IDLE], to generate a DMA request. When this bit is set, reading LPUART_DATA when either DATA[RXEMPT] or DATA[IDLINE] bit is set, will generate an End Of Packet response until the completion of the existing DMA transfer. During an End of Packet response, reading the LPUART_DATA register will return 0x0000_33FF and does not pull data from the FIFO. 0 - DMA request disabled. 1 - DMA request enabled.
19-18	Match Configuration
MATCFG	Configures the match addressing mode used. 00 - Address Match Wakeup 01 - Idle Match Wakeup 10 - Match On and Match Off 11 - Enables RWU on Data Match and Match On/Off for transmitter CTS input
17	Both Edge Sampling
BOTHEDGE	Enables sampling of the received data on both edges of the baud rate clock, effectively doubling the number of times the receiver samples the input data for a given oversampling ratio. This bit must be set for oversampling ratios between x4 and x7 and is optional for higher oversampling ratios. This bit should only be changed when the receiver is disabled. 0 - Receiver samples input data using the rising edge of the baud rate clock. 1 - Receiver samples input data using the rising and falling edge of the baud rate clock.
16	Resynchronization Disable
RESYNCDIS	When set, disables the resynchronization of the received data word when a data one followed by data zero transition is detected. This bit should only be changed when the receiver is disabled. 0 - Resynchronization during received data word is supported 1 - Resynchronization during received data word is disabled
15	LIN Break Detect Interrupt Enable
LBKDIE	LBKDIE enables the LIN break detect flag, LBKDIF, to generate interrupt requests. 0 - Hardware interrupts from LPUART_STAT[LBKDIF] disabled (use polling). 1 - Hardware interrupt requested when LPUART_STAT[LBKDIF] flag is 1.
14	RX Input Active Edge Interrupt Enable
RXEDGIE	Enables the receive input active edge, RXEDGIF, to generate interrupt requests. Changing CTRL[LOOP] or CTRL[RSRC] when RXEDGIE is set can cause the RXEDGIF to set. 0 - Hardware interrupts from LPUART_STAT[RXEDGIF] disabled (use polling). 1 - Hardware interrupt requested when LPUART_STAT[RXEDGIF] flag is 1.
13	Stop Bit Number Select
SBNS	SBNS determines whether data characters are one or two stop bits. This bit should only be changed when the transmitter and receiver are both disabled. 0 - One stop bit. 1 - Two stop bits.
12-0	Baud Rate Modulo Divisor.
SBR	The 13 bits in SBR[12:0] set the modulo divide rate for the baud rate generator. When SBR is 1 - 8191, the baud rate equals "baud clock / ((OSR+1) * SBR)". The 13-bit baud rate setting [SBR12:SBR0] must only be updated when the transmitter and receiver are both disabled (LPUART_CTRL[RE] and LPUART_CTRL[TE] are both 0).

46.3.1.7 LPUART Status (STAT)

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. $3,\,07/2018$

46.3.1.7.1 Address

Register	Offset
STAT	Base address + 14h offset

46.3.1.7.2 Diagram

Bits	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
R	LBKD IF	RXED GIF	MSBF	RXIN V	RWUI	BRK1	LBKD E	RAF	TDRE	тс	RDRF	IDLE	OR	NF	FE	PF
W	w1c	w1c		•		0	_					w1c	w1c	w1c	w1c	w1c
Reset	0	0	0	0	0	0	0	0	1	1	0	0	0	0	0	0
Bits	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
R	MA1F	MA2F							C)						
W	w1c	w1c														
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

46.3.1.7.3 Fields

Field	Function
31	LIN Break Detect Interrupt Flag
LBKDIF	LBKDIF is set when the LIN break detect circuitry is enabled and a LIN break character is detected. LBKDIF is cleared by writing a 1 to it. 0 - No LIN break character has been detected. 1 - LIN break character has been detected.
30	RXD Pin Active Edge Interrupt Flag
RXEDGIF	RXEDGIF is set when an active edge, falling if RXINV = 0, rising if RXINV=1, on the RXD pin occurs. RXEDGIF is cleared by writing a 1 to it. 0 - No active edge on the receive pin has occurred. 1 - An active edge on the receive pin has occurred.
29	MSB First
MSBF	Setting this bit reverses the order of the bits that are transmitted and received on the wire. This bit does not affect the polarity of the bits, the location of the parity bit or the location of the start or stop bits. This bit should only be changed when the transmitter and receiver are both disabled. 0 - LSB (bit0) is the first bit that is transmitted following the start bit. Further, the first bit received after the start bit is identified as bit0. 1 - MSB (bit9, bit8, bit7 or bit6) is the first bit that is transmitted following the start bit depending on the setting of CTRL[M], CTRL[PE] and BAUD[M10]. Further, the first bit received after the start bit is identified as bit9, bit8, bit7 or bit6 depending on the setting of CTRL[M] and CTRL[PE].
28	Receive Data Inversion
RXINV	Setting this bit reverses the polarity of the received data input.
	NOTE: Setting RXINV inverts the RXD input for all cases: data bits, start and stop bits, break, and idle.

Table continues on the next page...

Register definition

Field	Function
	0 - Receive data not inverted. 1 - Receive data inverted.
27	Receive Wake Up Idle Detect
RWUID	For RWU on idle character, RWUID controls whether the idle character that wakes up the receiver sets the IDLE bit. For address match wakeup, RWUID controls if the IDLE bit is set when the address does not match. This bit should only be changed when the receiver is disabled. 0 - During receive standby state (RWU = 1), the IDLE bit does not get set upon detection of an idle character. During address match wakeup, the IDLE bit does not get set when an address does not match. 1 - During receive standby state (RWU = 1), the IDLE bit gets set upon detection of an idle character. During address match wakeup, the IDLE bit does get set when an address does not match.
26	Break Character Generation Length
BRK13	BRK13 selects a longer transmitted break character length. Detection of a framing error is not affected by the state of this bit. This bit should only be changed when the transmitter is disabled. 0 - Break character is transmitted with length of 9 to 13 bit times. 1 - Break character is transmitted with length of 12 to 15 bit times.
25	LIN Break Detection Enable
LBKDE	LBKDE selects a longer break character detection length. While LBKDE is set, receive data is not stored in the receive data buffer. 0 - LIN break detect is disabled, normal break character can be detected. 1 - LIN break detect is enabled. LIN break character is detected at length of 11 bit times (if M = 0) or 12 (if M = 1) or 13 (M10 = 1).
24	Receiver Active Flag
RAF	RAF is set when the receiver detects the beginning of a valid start bit, and RAF is cleared automatically when the receiver detects an idle line. 0 - LPUART receiver idle waiting for a start bit. 1 - LPUART receiver active (RXD input not idle).
23	Transmit Data Register Empty Flag
TDRE	When the transmit FIFO is enabled, TDRE will set when the number of datawords in the transmit FIFO (LPUART_DATA) is equal to or less than the number indicated by LPUART_WATER[TXWATER]). To clear TDRE, write to the LPUART data register (LPUART_DATA) until the number of words in the transmit FIFO is greater than the number indicated by LPUART_WATER[TXWATER]. When the transmit FIFO is disabled, TDRE will set when the transmit data register (LPUART_DATA) is empty. To clear TDRE, write to the LPUART data register (LPUART_DATA).
	TDRE is not affected by a character that is in the process of being transmitted, it is updated at the start of each transmitted character.
	0 - Transmit data buffer full. 1 - Transmit data buffer empty.
22	Transmission Complete Flag
тс	TC is cleared when there is a transmission in progress or when a preamble or break character is loaded. TC is set when the transmit buffer is empty and no data, preamble, or break character is being transmitted. When TC is set, the transmit data output signal becomes idle (logic 1). TC is cleared by writing to LPUART_DATA to transmit new data, queuing a preamble by clearing and then setting LPUART_CTRL[TE], queuing a break character by writing 1 to LPUART_CTRL[SBK]. 0 - Transmitter active (sending data, a preamble, or a break). 1 - Transmitter idle (transmission activity complete).
21	Receive Data Register Full Flag

Table continues on the next page...

Field	Function
	When the receive FIFO is enabled, RDRF is set when the number of datawords in the receive buffer is greater than the number indicated by LPUART_WATER[RXWATER]. To clear RDRF, read LPUART_DATA until the number of datawords in the receive data buffer is equal to or less than the number indicated by LPUART_WATER[RXWATER]. When the receive FIFO is disabled, RDRF is set when the receive buffer (LPUART_DATA) is full. To clear RDRF, read the LPUART_DATA register.
	A character that is in the process of being received does not cause a change in RDRF until the entire character is received. Even if RDRF is set, the character will continue to be received until an overrun condition occurs once the entire character is received.
	0 - Receive data buffer empty. 1 - Receive data buffer full.
20	Idle Line Flag
IDLE	IDLE is set when the LPUART receive line becomes idle for a full character time after a period of activity. When ILT is cleared, the receiver starts counting idle bit times after the start bit. If the receive character is all 1s, these bit times and the stop bits time count toward the full character time of logic high, 10 to 13 bit times, needed for the receiver to detect an idle line. When ILT is set, the receiver doesn't start counting idle bit times until after the stop bits. The stop bits and any logic high bit times at the end of the previous character do not count toward the full character time of logic high needed for the receiver to detect an idle line.
	To clear IDLE, write logic 1 to the IDLE flag. After IDLE has been cleared, it cannot become set again until after a new character has been stored in the receive buffer or a LIN break character has set the LBKDIF flag. IDLE is set only once even if the receive line remains idle for an extended period.
	0 - No idle line detected. 1 - Idle line was detected.
19	Receiver Overrun Flag
OR	OR is set when software fails to prevent the receive data register from overflowing with data. The OR bit is set immediately after the stop bit has been completely received for the dataword that overflows the buffer and all the other error flags (FE, NF, and PF) are prevented from setting. The data in the shift register is lost, but the data already in the LPUART data registers is not affected. If LBKDE is enabled and a LIN Break is detected, the OR field asserts if LBKDIF is not cleared before the next data character is received.
	While the OR flag is set, no additional data is stored in the data buffer even if sufficient room exists. To clear OR, write logic 1 to the OR flag.
	0 - No overrun. 1 - Receive overrun (new LPUART data lost).
18	Noise Flag
NF	The advanced sampling technique used in the receiver takes three samples in each of the received bits. If any of these samples disagrees with the rest of the samples within any bit time in the frame then noise is detected for that character. NF is set whenever the next character to be read from LPUART_DATA was received with noise detected within the character. To clear NF, write logic one to the NF. 0 - No noise detected. 1 - Noise detected in the received character in LPUART_DATA.
17	Framing Error Flag
FE	FE is set whenever the next character to be read from LPUART_DATA was received with logic 0 detected where a stop bit was expected. To clear FE, write logic one to the FE. 0 - No framing error detected. This does not guarantee the framing is correct. 1 - Framing error.
16	Parity Error Flag
PF	PF is set whenever the next character to be read from LPUART_DATA was received when parity is enabled (PE = 1) and the parity bit in the received character does not agree with the expected parity value. To clear PF, write a logic one to the PF.

Table continues on the next page...

Register definition

Field	Function
	0 - No parity error. 1 - Parity error.
15	Match 1 Flag
MA1F	MA1F is set whenever the next character to be read from LPUART_DATA matches MA1. To clear MA1F, write a logic one to the MA1F. 0 - Received data is not equal to MA1 1 - Received data is equal to MA1
14	Match 2 Flag
MA2F	MA2F is set whenever the next character to be read from LPUART_DATA matches MA2. To clear MA2F, write a logic one to the MA2F. 0 - Received data is not equal to MA2 1 - Received data is equal to MA2
13-0	Reserved
_	

46.3.1.8 LPUART Control (CTRL)

46.3.1.8.1 Address

Register	Offset
CTRL	Base address + 18h offset

46.3.1.8.2 Function

This read/write register controls various optional features of the LPUART system. This register should only be altered when the transmitter and receiver are both disabled.

46.3.1.8.3 Diagram



Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

46.3.1.8.4 Fields

Field	Function
31	Receive Bit 8 / Transmit Bit 9
R8T9	R8 is the ninth data bit received when the LPUART is configured for 9-bit or 10-bit data formats. When reading 9-bit or 10-bit data, read R8 before reading LPUART_DATA.
	T9 is the tenth data bit received when the LPUART is configured for 10-bit data formats. When writing 10-bit data, write T9 before writing LPUART_DATA. If T9 does not need to change from its previous value, such as when it is used to generate address mark or parity, they it need not be written each time LPUART_DATA is written.
30	Receive Bit 9 / Transmit Bit 8
R9T8	R9 is the tenth data bit received when the LPUART is configured for 10-bit data formats. When reading 10-bit data, read R9 before reading LPUART_DATA
	T8 is the ninth data bit received when the LPUART is configured for 9-bit or 10-bit data formats. When writing 9-bit or 10-bit data, write T8 before writing LPUART_DATA. If T8 does not need to change from its previous value, such as when it is used to generate address mark or parity, they it need not be written each time LPUART_DATA is written.
29	TXD Pin Direction in Single-Wire Mode
TXDIR	When the LPUART is configured for single-wire half-duplex operation (LOOPS = RSRC = 1), this bit determines the direction of data at the TXD pin. When clearing TXDIR, the transmitter will finish receiving the current character (if any) before the receiver starts receiving data from the TXD pin. 0 - TXD pin is an input in single-wire mode. 1 - TXD pin is an output in single-wire mode.
28	Transmit Data Inversion
TXINV	Setting this bit reverses the polarity of the transmitted data output.
	NOTE: Setting TXINV inverts the TXD output for all cases: data bits, start and stop bits, break, and idle. 0 - Transmit data not inverted. 1 - Transmit data inverted.
27	Overrun Interrupt Enable
ORIE	This bit enables the overrun flag (OR) to generate hardware interrupt requests. 0 - OR interrupts disabled; use polling. 1 - Hardware interrupt requested when OR is set.
26	Noise Error Interrupt Enable
NEIE	This bit enables the noise flag (NF) to generate hardware interrupt requests. 0 - NF interrupts disabled; use polling. 1 - Hardware interrupt requested when NF is set.
25	Framing Error Interrupt Enable
FEIE	This bit enables the framing error flag (FE) to generate hardware interrupt requests. 0 - FE interrupts disabled; use polling. 1 - Hardware interrupt requested when FE is set.
24	Parity Error Interrupt Enable
PEIE	This bit enables the parity error flag (PF) to generate hardware interrupt requests. 0 - PF interrupts disabled; use polling). 1 - Hardware interrupt requested when PF is set.
23	Transmit Interrupt Enable
TIE	Enables STAT[TDRE] to generate interrupt requests. 0 - Hardware interrupts from TDRE disabled; use polling.

Table continues on the next page...

Register definition

Field	Function
	1 - Hardware interrupt requested when TDRE flag is 1.
22	Transmission Complete Interrupt Enable for
TCIE	TCIE enables the transmission complete flag, TC, to generate interrupt requests. 0 - Hardware interrupts from TC disabled; use polling. 1 - Hardware interrupt requested when TC flag is 1.
21	Receiver Interrupt Enable
RIE	Enables STAT[RDRF] to generate interrupt requests. 0 - Hardware interrupts from RDRF disabled; use polling. 1 - Hardware interrupt requested when RDRF flag is 1.
20	Idle Line Interrupt Enable
ILIE	ILIE enables the idle line flag, STAT[IDLE], to generate interrupt requests. 0 - Hardware interrupts from IDLE disabled; use polling. 1 - Hardware interrupt requested when IDLE flag is 1.
19	Transmitter Enable
TE	Enables the LPUART transmitter. TE can also be used to queue an idle preamble by clearing and then setting TE. When TE is cleared, this register bit will read as 1 until the transmitter has completed the current character and the TXD pin is tristated. 0 - Transmitter disabled. 1 - Transmitter enabled.
18	Receiver Enable
RE	Enables the LPUART receiver. When RE is written to 0, this register bit will read as 1 until the receiver finishes receiving the current character (if any). 0 - Receiver disabled. 1 - Receiver enabled.
17	Receiver Wakeup Control
RWU	This field can be set to place the LPUART receiver in a standby state. RWU automatically clears when ar RWU event occurs, that is, an IDLE event when CTRL[WAKE] is clear or an address match when CTRL[WAKE] is set with STAT[RWUID] is clear.
	NOTE: RWU must be set only with CTRL[WAKE] = 0 (wakeup on idle) if the channel is currently not idle. This can be determined by STAT[RAF]. If the flag is set to wake up an IDLE event and the channel is already idle, it is possible that the LPUART will discard data. This is because the data must be received or a LIN break detected after an IDLE is detected before IDLE is allowed to be reasserted. 0 - Normal receiver operation. 1 - LPUART receiver in standby waiting for wakeup condition.
16	Send Break
SBK	Writing a 1 and then a 0 to SBK queues a break character in the transmit data stream. Additional break characters of 9 to 13 bits, or 12 to 15 bits if LPUART_STAT[BRK13] is set, bit times of logic 0 are queued as long as SBK is set. Depending on the timing of the set and clear of SBK relative to the information currently being transmitted, a second break character may be queued before software clears SBK. 0 - Normal transmitter operation. 1 - Queue break character(s) to be sent.
15	Match 1 Interrupt Enable
MA1IE	0 - MA1F interrupt disabled 1 - MA1F interrupt enabled
14	Match 2 Interrupt Enable
MA2IE	0 - MA2F interrupt disabled 1 - MA2F interrupt enabled

Table continues on the next page...

Chapter 46 Low Power Universal Asynchronous Receiver/Transmitter (LPUART)

Field	Function
13-12	Reserved
_	
11	7-Bit Mode Select
M7	This bit should only be changed when the transmitter and receiver are both disabled. 0 - Receiver and transmitter use 8-bit to 10-bit data characters. 1 - Receiver and transmitter use 7-bit data characters.
10-8	Idle Configuration
IDLECFG	Configures the number of idle characters that must be received before the IDLE flag is set. 000 - 1 idle character 001 - 2 idle characters 010 - 4 idle characters 011 - 8 idle characters 100 - 16 idle characters 101 - 32 idle characters 110 - 64 idle characters 111 - 128 idle characters
7	Loop Mode Select
LOOPS	When LOOPS is set, the RXD pin is disconnected from the LPUART and the transmitter output is internally connected to the receiver input. The transmitter and the receiver must be enabled to use the loop function. 0 - Normal operation - RXD and TXD use separate pins. 1 - Loop mode or single-wire mode where transmitter outputs are internally connected to receiver input (see RSRC bit).
6	Doze Enable
DOZEEN	0 - LPUART is enabled in Doze mode. 1 - LPUART is disabled in Doze mode.
5	Receiver Source Select
RSRC	This field has no meaning or effect unless the LOOPS field is set. When LOOPS is set, the RSRC field determines the source for the receiver shift register input. 0 - Provided LOOPS is set, RSRC is cleared, selects internal loop back mode and the LPUART does not use the RXD pin. 1 - Single-wire LPUART mode where the TXD pin is connected to the transmitter output and receiver input.
4	9-Bit or 8-Bit Mode Select
М	Receiver and transmitter use 8-bit data characters. Receiver and transmitter use 9-bit data characters.
3	Receiver Wakeup Method Select
WAKE	Determines which condition wakes the LPUART when RWU=1: • Address mark in the most significant bit position of a received data character, or • An idle condition on the receive pin input signal. 0 - Configures RWU for idle-line wakeup. 1 - Configures RWU with address-mark wakeup.
2	Idle Line Type Select
ILT	Determines when the receiver starts counting logic 1s as idle character bits. The count begins either after a valid start bit or after the stop bit. If the count begins after the start bit, then a string of logic 1s preceding the stop bit can cause false recognition of an idle character. Beginning the count after the stop bit avoids false idle character recognition, but requires properly synchronized transmissions.

Table continues on the next page...

Register definition

Field	Function
	NOTE: In case the LPUART is programmed with ILT = 1, a logic 0 is automatically shifted after a received stop bit, therefore resetting the idle count. 0 - Idle character bit count starts after start bit. 1 - Idle character bit count starts after stop bit.
1	Parity Enable
PE	Enables hardware parity generation and checking. When parity is enabled, the bit immediately before the stop bit is treated as the parity bit. 0 - No hardware parity generation or checking. 1 - Parity enabled.
0	Parity Type
PT	Provided parity is enabled (PE = 1), this bit selects even or odd parity. Odd parity means the total number of 1s in the data character, including the parity bit, is odd. Even parity means the total number of 1s in the data character, including the parity bit, is even. 0 - Even parity. 1 - Odd parity.

46.3.1.9 LPUART Data (DATA)

46.3.1.9.1 Address

Register	Offset
DATA	Base address + 1Ch offset

46.3.1.9.2 Function

This register is actually two separate registers. Reads return the contents of the read-only receive data buffer and writes go to the write-only transmit data buffer. Reads and writes of this register are also involved in the automatic flag clearing mechanisms for some of the LPUART status flags.

46.3.1.9.3 Diagram

Bits	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
R								()							
W																
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
									ı							
Bits	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
R	NOIS Y	PARI TYE	FRET	RXE MPT	IDLI NE	0	R9T9	R8T8	R7T7	R6T6	R5T5	R4T4	R3T3	R2T2	R1T1	R0T0
W			30													
Reset	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0

46.3.1.9.4 Fields

Field	Function
31-16	Reserved
_	
15	NOISY
NOISY	The current received dataword contained in DATA[R9:R0] was received with noise. 0 - The dataword was received without noise. 1 - The data was received with noise.
14	PARITYE
PARITYE	The current received dataword contained in DATA[R9:R0] was received with a parity error. 0 - The dataword was received without a parity error. 1 - The dataword was received with a parity error.
13	Frame Error / Transmit Special Character
FRETSC	For reads, indicates the current received dataword contained in DATA[R9:R0] was received with a frame error. For writes, indicates a break or idle character is to be transmitted instead of the contents in DATA[T9:T0]. T9 is used to indicate a break character when 0 and a idle character when 1, he contents of DATA[T8:T0] should be zero. 0 - The dataword was received without a frame error on read, transmit a normal character on write. 1 - The dataword was received with a frame error, transmit an idle or break character on transmit.
12	Receive Buffer Empty
RXEMPT	Asserts when there is no data in the receive buffer. This field does not take into account data that is in the receive shift register. 0 - Receive buffer contains valid data. 1 - Receive buffer is empty, data returned on read is not valid.
11	Idle Line
IDLINE	Indicates the receiver line was idle before receiving the character in DATA[9:0]. Unlike the IDLE flag, this bit can set for the first character received when the receiver is first enabled. 0 - Receiver was not idle before receiving this character. 1 - Receiver was idle before receiving this character.
10	Reserved

Table continues on the next page...

Register definition

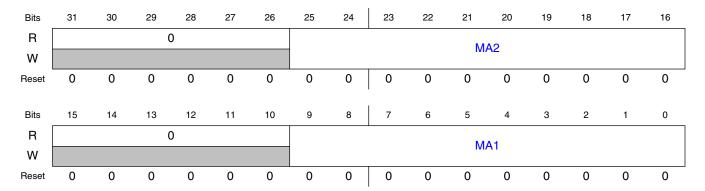
Field	Function
9	R9T9
R9T9	Read receive data buffer 9 or write transmit data buffer 9.
8	R8T8
R8T8	Read receive data buffer 8 or write transmit data buffer 8.
7	R7T7
R7T7	Read receive data buffer 7 or write transmit data buffer 7.
6	R6T6
R6T6	Read receive data buffer 6 or write transmit data buffer 6.
5	R5T5
R5T5	Read receive data buffer 5 or write transmit data buffer 5.
4	R4T4
R4T4	Read receive data buffer 4 or write transmit data buffer 4.
3	R3T3
R3T3	Read receive data buffer 3 or write transmit data buffer 3.
2	R2T2
R2T2	Read receive data buffer 2 or write transmit data buffer 2.
1	R1T1
R1T1	Read receive data buffer 1 or write transmit data buffer 1.
0	R0T0
R0T0	Read receive data buffer 0 or write transmit data buffer 0.

46.3.1.10 LPUART Match Address (MATCH)

46.3.1.10.1 Address

Register	Offset							
MATCH	Base address + 20h offset							

46.3.1.10.2 Diagram



46.3.1.10.3 Fields

Field	Function
31-26	Reserved
_	
25-16	Match Address 2
MA2	The MA1 and MA2 registers are compared to input data addresses when the most significant bit is set and the associated BAUD[MAEN] bit is set. If a match occurs, the following data is transferred to the data register. If a match fails, the following data is discarded. Software should only write a MA register when the associated BAUD[MAEN] bit is clear.
15-10	Reserved
_	
9-0	Match Address 1
MA1	The MA1 and MA2 registers are compared to input data addresses when the most significant bit is set and the associated BAUD[MAEN] bit is set. If a match occurs, the following data is transferred to the data register. If a match fails, the following data is discarded. Software should only write a MA register when the associated BAUD[MAEN] bit is clear.

46.3.1.11 LPUART Modem IrDA (MODIR)

46.3.1.11.1 Address

Register	Offset							
MODIR	Base address + 24h offset							

46.3.1.11.2 Function

The MODEM register controls options for setting the modem configuration.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

46.3.1.11.3 Diagram

Bits	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
R							0							IREN	TN	NP
w														INCIN	"	NF
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Bits	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
R				DTCM	/ATER				()	TXCT	TXCT	RXRT	TXRT	TXRT	TXCT
w				niow	IAIEN						SSRC	SC	SE	SPOL	SE	SE
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

46.3.1.11.4 Fields

Field	Function
31-19	Reserved
_	
18	Infrared enable
IREN	Enables/disables the infrared modulation/demodulation. 0 - IR disabled. 1 - IR enabled.
17-16	Transmitter narrow pulse
TNP	Configures whether the LPUART transmits a 1/OSR, 2/OSR, 3/OSR or 4/OSR narrow pulse when IR is enabled.
	The IR pulse width should be configured to less than half of the oversampling ratio. Common pulse widths are 3/16, 1/16, 1/32 or 1/4 of the bit length. These can be configured by selecting the appropriate oversample ratio and pulse width.
	00 - 1/OSR. 01 - 2/OSR. 10 - 3/OSR. 11 - 4/OSR.
15-8	Receive RTS Configuration
RTSWATER	Configures the point at which the RX RTS output negates based on the number of additional characters that can be stored in the Receive FIFO. When configured to 0 with receiver controlling RTS, it negates when the start bit is detetected for the character that will cause the FIFO to become full, and it asserts when the FIFO is not full and the character being received would not cause the FIFO to become full.
7-6	Reserved
_	
5	Transmit CTS Source
TXCTSSRC	Configures the source of the CTS input. 0 - CTS input is the CTS_B pin. 1 - CTS input is the inverted Receiver Match result.
4	Transmit CTS Configuration

Table continues on the next page...

1200

Chapter 46 Low Power Universal Asynchronous Receiver/Transmitter (LPUART)

Field	Function
TXCTSC	Configures if the CTS state is checked at the start of each character or only when the transmitter is idle. 0 - CTS input is sampled at the start of each character. 1 - CTS input is sampled when the transmitter is idle.
3	Receiver request-to-send enable
RXRTSE	Allows the RTS output to control the CTS input of the transmitting device to prevent receiver overrun.
	NOTE: Do not set both RXRTSE and TXRTSE. 0 - The receiver has no effect on RTS. 1 - RTS is deasserted if the receiver data register is full or a start bit has been detected that would cause the receiver data register to become full. RTS is asserted if the receiver data register is not full and has not detected a start bit that would cause the receiver data register to become full.
2	Transmitter request-to-send polarity
TXRTSPOL	Controls the polarity of the transmitter RTS. TXRTSPOL does not affect the polarity of the receiver RTS. RTS will remain negated in the active low state unless TXRTSE is set. 0 - Transmitter RTS is active low. 1 - Transmitter RTS is active high.
1	Transmitter request-to-send enable
TXRTSE	Controls RTS before and after a transmission. 0 - The transmitter has no effect on RTS. 1 - When a character is placed into an empty transmitter data buffer, RTS asserts one bit time before the start bit is transmitted. RTS deasserts one bit time after all characters in the transmitter data buffer and shift register are completely sent, including the last stop bit.
0	Transmitter clear-to-send enable
TXCTSE	TXCTSE controls the operation of the transmitter. TXCTSE can be set independently from the state of TXRTSE and RXRTSE. 0 - CTS has no effect on the transmitter. 1 - Enables clear-to-send operation. The transmitter checks the state of CTS each time it is ready to send a character. If CTS is asserted, the character is sent. If CTS is deasserted, the signal TXD remains in the mark state and transmission is delayed until CTS is asserted. Changes in CTS as a character is being sent do not affect its transmission.

46.3.1.12 LPUART FIFO (FIFO)

46.3.1.12.1 Address

Register	Offset							
FIFO	Base address + 28h offset							

46.3.1.12.2 Function

This register provides the ability for the programmer to turn on and off FIFO functionality. It also provides the size of the FIFO that has been implemented. This register may be read at any time. This register must be written only when CTRL[RE] and CTRL[TE] are cleared/not set and when the data buffer/FIFO is empty.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

46.3.1.12.3 Diagram

Bits	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
R					0				TXEM PT	RXE MPT			0		TXOF	RXUF
W															w1c	w1c
Reset	0	0	0	0	0	0	0	0	1	1	0	0	0	0	0	0
Bits	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
R	0	0	0				TXOF	RXUF		TX	FIFOSI	ZE		R	(FIFOSI	ZE
W	TXFL USH	RXFL USH			RXIDEN		E	E	TXFE				RXFE			
Reset	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	1

46.3.1.12.4 Fields

Field	Function
31-24 —	Reserved
23	Transmit Buffer/FIFO Empty
TXEMPT	Asserts when there is no data in the Transmit FIFO/buffer. This field does not take into account data that is in the transmit shift register. 0 - Transmit buffer is not empty. 1 - Transmit buffer is empty.
22	Receive Buffer/FIFO Empty
RXEMPT	Asserts when there is no data in the receive FIFO/Buffer. This field does not take into account data that is in the receive shift register. 0 - Receive buffer is not empty. 1 - Receive buffer is empty.
21-18	Reserved
_	
17	Transmitter Buffer Overflow Flag
TXOF	Indicates that more data has been written to the transmit buffer than it can hold. This field will assert regardless of the value of TXOFE. However, an interrupt will be issued to the host only if TXOFE is set. This flag is cleared by writing a 1. 0 - No transmit buffer overflow has occurred since the last time the flag was cleared. 1 - At least one transmit buffer overflow has occurred since the last time the flag was cleared.
16	Receiver Buffer Underflow Flag
RXUF	Indicates that more data has been read from the receive buffer than was present. This field will assert regardless of the value of RXUFE. However, an interrupt will be issued to the host only if RXUFE is set. This flag is cleared by writing a 1. 0 - No receive buffer underflow has occurred since the last time the flag was cleared. 1 - At least one receive buffer underflow has occurred since the last time the flag was cleared.
15	Transmit FIFO/Buffer Flush

Table continues on the next page...

Chapter 46 Low Power Universal Asynchronous Receiver/Transmitter (LPUART)

Field	Function				
TXFLUSH	Writing to this field causes all data that is stored in the transmit FIFO/buffer to be flushed. This does not affect data that is in the transmit shift register. 0 - No flush operation occurs. 1 - All data in the transmit FIFO/Buffer is cleared out.				
14	Receive FIFO/Buffer Flush				
RXFLUSH	Writing to this field causes all data that is stored in the receive FIFO/buffer to be flushed. This does not affect data that is in the receive shift register. 0 - No flush operation occurs. 1 - All data in the receive FIFO/buffer is cleared out.				
13	Reserved				
_					
12-10	Receiver Idle Empty Enable				
RXIDEN	When set, enables the assertion of RDRF when the receiver is idle for a number of idle characters and the FIFO is not empty. 000 - Disable RDRF assertion due to partially filled FIFO when receiver is idle. 001 - Enable RDRF assertion due to partially filled FIFO when receiver is idle for 1 character. 010 - Enable RDRF assertion due to partially filled FIFO when receiver is idle for 2 characters. 011 - Enable RDRF assertion due to partially filled FIFO when receiver is idle for 4 characters. 100 - Enable RDRF assertion due to partially filled FIFO when receiver is idle for 8 characters. 101 - Enable RDRF assertion due to partially filled FIFO when receiver is idle for 16 characters. 110 - Enable RDRF assertion due to partially filled FIFO when receiver is idle for 32 characters. 111 - Enable RDRF assertion due to partially filled FIFO when receiver is idle for 64 characters.				
9	Transmit FIFO Overflow Interrupt Enable				
TXOFE	When this field is set, the TXOF flag generates an interrupt to the host. 0 - TXOF flag does not generate an interrupt to the host. 1 - TXOF flag generates an interrupt to the host.				
8	Receive FIFO Underflow Interrupt Enable				
RXUFE	When this field is set, the RXUF flag generates an interrupt to the host. 0 - RXUF flag does not generate an interrupt to the host. 1 - RXUF flag generates an interrupt to the host.				
7	Transmit FIFO Enable				
TXFE	When this field is set, the built in FIFO structure for the transmit buffer is enabled. The size of the FIFO structure is indicated by TXFIFOSIZE. If this field is not set, the transmit buffer operates as a FIFO of depth one dataword regardless of the value in TXFIFOSIZE. Both CTRL[TE] and CTRL[RE] must be cleared prior to changing this field. 0 - Transmit FIFO is not enabled. Buffer is depth 1. (Legacy support). 1 - Transmit FIFO is enabled. Buffer is depth indicated by TXFIFOSIZE.				
6-4	Transmit FIFO. Buffer Depth				
TXFIFOSIZE	The maximum number of transmit datawords that can be stored in the transmit buffer. This field is read only. 000 - Transmit FIFO/Buffer depth = 1 dataword. 001 - Transmit FIFO/Buffer depth = 4 datawords. 010 - Transmit FIFO/Buffer depth = 8 datawords. 011 - Transmit FIFO/Buffer depth = 16 datawords. 100 - Transmit FIFO/Buffer depth = 32 datawords. 101 - Transmit FIFO/Buffer depth = 64 datawords. 110 - Transmit FIFO/Buffer depth = 128 datawords. 111 - Transmit FIFO/Buffer depth = 256 datawords				
3	Receive FIFO Enable				
RXFE					
=					

Table continues on the next page...

Register definition

Field	Function			
	When this field is set, the built in FIFO structure for the receive buffer is enabled. The size of the FIFO structure is indicated by the RXFIFOSIZE field. If this field is not set, the receive buffer operates as a FIFO of depth one dataword regardless of the value in RXFIFOSIZE. Both CTRL[TE] and CTRL[RE] must be cleared prior to changing this field. 0 - Receive FIFO is not enabled. Buffer is depth 1. (Legacy support) 1 - Receive FIFO is enabled. Buffer is depth indicted by RXFIFOSIZE.			
2-0	Receive FIFO. Buffer Depth			
RXFIFOSIZE	The maximum number of receive datawords that can be stored in the receive buffer before an overrun occurs. This field is read only. 000 - Receive FIFO/Buffer depth = 1 dataword. 001 - Receive FIFO/Buffer depth = 4 datawords. 010 - Receive FIFO/Buffer depth = 8 datawords. 011 - Receive FIFO/Buffer depth = 16 datawords. 100 - Receive FIFO/Buffer depth = 32 datawords. 101 - Receive FIFO/Buffer depth = 64 datawords. 110 - Receive FIFO/Buffer depth = 128 datawords. 111 - Receive FIFO/Buffer depth = 256 datawords.			

46.3.1.13 LPUART Watermark (WATER)

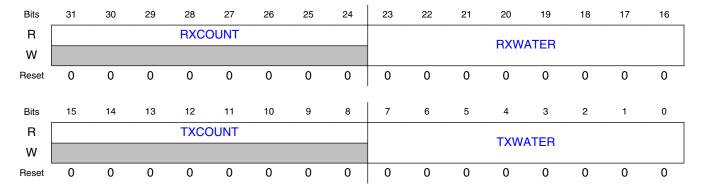
46.3.1.13.1 Address

Register	Offset
WATER	Base address + 2Ch offset

46.3.1.13.2 Function

This register provides the ability to set a programmable threshold for notification of needing additional transmit data. This register may be read at any time but must be written only when CTRL[TE] is not set.

46.3.1.13.3 Diagram



Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

46.3.1.13.4 Fields

Field	Function
31-24	Receive Counter
RXCOUNT	The value in this register indicates the number of datawords that are in the receive FIFO/buffer. If a dataword is being received, that is, in the receive shift register, it is not included in the count. This value may be used in conjunction with FIFO[RXFIFOSIZE] to calculate how much room is left in the receive FIFO/buffer.
23-16	Receive Watermark
RXWATER	When the number of datawords in the receive FIFO/buffer is greater than the value in this register field, an interrupt or a DMA request is generated. For proper operation, the value in RXWATER must be set to be less than the receive FIFO/buffer size as indicated by FIFO[RXFIFOSIZE] and FIFO[RXFE] and must be greater than 0.
15-8	Transmit Counter
TXCOUNT	The value in this register indicates the number of datawords that are in the transmit FIFO/buffer. If a dataword is being transmitted, that is, in the transmit shift register, it is not included in the count. This value may be used in conjunction with FIFO[TXFIFOSIZE] to calculate how much room is left in the transmit FIFO/buffer.
7-0	Transmit Watermark
TXWATER	When the number of datawords in the transmit FIFO/buffer is equal to or less than the value in this register field, an interrupt or a DMA request is generated. For proper operation, the value in TXWATER must be set to be less than the size of the transmit buffer/FIFO size as indicated by FIFO[TXFIFOSIZE] and FIFO[TXFE].

46.4 Functional description

The LPUART supports full-duplex, asynchronous, NRZ serial communication and comprises a baud rate generator, transmitter, and receiver block. The transmitter and receiver operate independently, although they use the same baud rate generator. The following describes each of the blocks of the LPUART.

46.4.1 Baud rate generation

A 13-bit modulus counter in the baud rate generator derive the baud rate for both the receiver and the transmitter. The value from 1 to 8191 written to SBR[12:0] determines the baud clock divisor for the asynchronous LPUART baud clock. The SBR bits are in the LPUART baud rate registers, BDH and BDL. The baud rate clock drives the receiver, while the transmitter is driven by the baud rate clock divided by the over sampling ratio. Depending on the over sampling ratio, the receiver has an acquisition rate of 4 to 32 samples per bit time.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

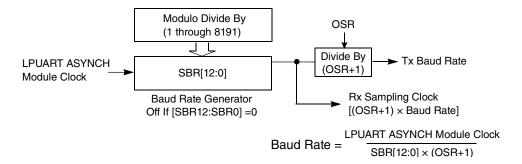


Figure 46-3. LPUART baud rate generation

Baud rate generation is subject to two sources of error:

- Integer division of the asynchronous LPUART baud clock may not give the exact target frequency.
- Synchronization with the asynchronous LPUART baud clock can cause phase shift.

46.4.2 Transmitter functional description

This section describes the overall block diagram for the LPUART transmitter, as well as specialized functions for sending break and idle characters.

The transmitter output (TXD) idle state defaults to logic high, CTRL[TXINV] is cleared following reset. The transmitter output is inverted by setting CTRL[TXINV]. The transmitter is enabled by setting the CTRL[TE] bit. This queues a preamble character that is one full character frame of the idle state. The transmitter then remains idle until data is available in the transmit data buffer. Programs store data into the transmit data buffer by writing to the LPUART data register.

The central element of the LPUART transmitter is the transmit shift register that is 9-bit to 13 bits long depending on the setting in the CTRL[M], CTRL[M7], BAUD[M10] and BAUD[SBNS] control bits. For the remainder of this section, assume CTRL[M], CTRL[M7], BAUD[M10] and BAUD[SBNS] are cleared, selecting the normal 8-bit data mode. In 8-bit data mode, the shift register holds a start bit, eight data bits, and a stop bit. When the transmit shift register is available for a new character, the value waiting in the transmit data register is transferred to the shift register, synchronized with the baud rate clock, and the transmit data register empty (STAT[TDRE]) status flag is set to indicate another character may be written to the transmit data buffer at LPUART_DATA.

If no new character is waiting in the transmit data buffer after a stop bit is shifted out the TXD pin, the transmitter sets the transmit complete flag and enters an idle mode, with TXD high, waiting for more characters to transmit.

Writing 0 to CTRL[TE] does not immediately disable the transmitter. The current transmit activity in progress must first be completed (that could include a data character, idle character or break character), although the transmitter will not start transmitting another character.

Send break and queued idle 46.4.2.1

The LPUART_CTRL[SBK] bit sends break characters originally used to gain the attention of old teletype receivers. Break characters are a full character time of logic 0, 9bit to 12-bit times including the start and stop bits. A longer break of 13-bit times can be enabled by setting LPUART_STAT[BRK13]. Normally, a program would wait for LPUART_STAT[TDRE] to become set to indicate the last character of a message has moved to the transmit shifter, write 1, and then write 0 to the LPUART CTRL[SBK] bit. This action queues a break character to be sent as soon as the shifter is available. If LPUART_CTRL[SBK] remains 1 when the queued break moves into the shifter, synchronized to the baud rate clock, an additional break character is queued. If the receiving device is another Freescale Semiconductor LPUART, the break characters are received as 0s in all data bits and a framing error (LPUART_STAT[FE] = 1) occurs.

A break character can also be transmitted by writing to the LPUART_DATA register with bit 13 set and the data bits clear. This supports transmitting the break character as part of the normal data stream and also allows the DMA to transmit a break character.

When idle-line wakeup is used, a full character time of idle (logic 1) is needed between messages to wake up any sleeping receivers. Normally, a program would wait for LPUART STAT[TDRE] to become set to indicate the last character of a message has moved to the transmit shifter, then write 0 and then write 1 to the LPUART_CTRL[TE] bit. This action gueues an idle character to be sent as soon as the shifter is available. As long as the character in the shifter does not finish while LPUART CTRL[TE] is cleared, the LPUART transmitter never actually releases control of the TXD pin.

An idle character can also be transmitted by writing to the LPUART DATA register with bit 13 set and the data bits also set. This supports transmitting the idle character as part of the normal data stream and also allows the DMA to transmit a break character.

The length of the break character is affected by the LPUART_STAT[BRK13], LPUART_CTRL[M], LPUART_CTRL[M7], LPUART_BAUD[M10] and LPUART BAUD[SNBS] bits as shown below.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

1207

Table 46-2. Break character length

BRK13	М	M10	М7	SBNS	Break character length
0	0	0	0	0	10 bit times
0	0	0	0	1	11 bit times
0	0	0	1	0	9 bit times
0	0	0	1	1	10 bit times
0	1	0	X	0	11 bit times
0	1	0	Х	1	12 bit times
0	X	1	X	0	12 bit times
0	X	1	X	1	13 bit times
1	0	0	0	0	13 bit times
1	0	0	0	1	13 bit times
1	0	0	1	0	12 bit times
1	0	0	1	1	12 bit times
1	1	0	Х	0	14 bit times
1	1	0	Х	1	14 bit times
1	Х	1	Х	0	15 bit times
1	Х	1	Х	1	15 bit times

46.4.2.2 Hardware flow control

The transmitter supports hardware flow control by gating the transmission with the value of CTS_B. If the clear-to-send operation is enabled, the character is transmitted when CTS_B is asserted. If CTS_B is deasserted in the middle of a transmission with characters remaining in the receiver data buffer, the character in the shift register is sent and TXD remains in the mark state until CTS_B is reasserted.

If the clear-to-send operation is disabled, the transmitter ignores the state of CTS_B.

The transmitter's CTS_B signal can also be enabled even if the same LPUART receiver's RTS_B signal is disabled.

46.4.2.3 Transceiver driver enable

The transmitter can use RTS_B as an enable signal for the driver of an external transceiver. See Transceiver driver enable using RTS_B for details. If the request-to-send operation is enabled, when a character is placed into an empty transmitter data buffer, RTS_B asserts one bit time before the start bit is transmitted. RTS_B remains asserted for the whole time that the transmitter data buffer has any characters. RTS_B deasserts one

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

bit time after all characters in the transmitter data buffer and shift register are completely sent, including the last stop bit. Transmitting a break character also asserts RTS_B, with the same assertion and deassertion timing as having a character in the transmitter data buffer.

The transmitter's RTS_B signal asserts only when the transmitter is enabled. However, the transmitter's RTS B signal is unaffected by its CTS B signal. RTS B will remain asserted until the transfer is completed, even if the transmitter is disabled mid-way through a data transfer.

Transceiver driver enable using RTS B 46.4.2.4

RS-485 is a multiple drop communication protocol in which the LPUART transceiver's driver is 3-stated unless the LPUART is driving. The RTS_B signal can be used by the transmitter to enable the driver of a transceiver. The polarity of RTS_B can be matched to the polarity of the transceiver's driver enable signal.

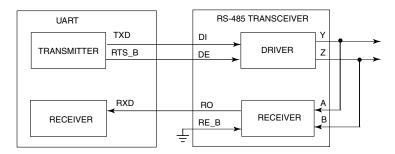


Figure 46-4. Transceiver driver enable using RTS_B

In the figure, the receiver enable signal is asserted. Another option for this connection is to connect RTS B to both DE and RE B. The transceiver's receiver is disabled while driving. A pullup can pull RXD to a non-floating value during this time. This option can be refined further by operating the LPUART in single wire mode, freeing the RXD pin for other uses.

Receiver functional description 46.4.3

In this section, the receiver block diagram is a guide for the overall receiver functional description. Next, the data sampling technique used to reconstruct receiver data is described in more detail. Finally, different variations of the receiver wakeup function are explained.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

1209

Functional description

The receiver input is inverted by setting LPUART_STAT[RXINV]. The receiver is enabled by setting the LPUART_CTRL[RE] bit. Character frames consist of a start bit of logic 0, seven to ten data bits (msb or lsb first), and one or two stop bits of logic 1. For information about 7-bit, 9-bit or 10-bit data mode, refer to Data Modes. For the remainder of this discussion, assume the LPUART is configured for normal 8-bit data mode.

After receiving the stop bit into the receive shifter, and provided the receive data register is not already full, the data character is transferred to the receive data register and the receive data register full (LPUART_STAT[RDRF]) status flag is set. If LPUART_STAT[RDRF] was already set indicating the receive data register (buffer) was already full, the overrun (OR) status flag is set and the new data is lost. Because the LPUART receiver is double-buffered, the program has one full character time after LPUART_STAT[RDRF] is set before the data in the receive data buffer must be read to avoid a receiver overrun.

When a program detects that the receive data register is full (LPUART_STAT[RDRF] = 1), it gets the data from the receive data register by reading LPUART_DATA. Refer to Interrupts and status flags for details about flag clearing.

46.4.3.1 Data sampling technique

The LPUART receiver supports a configurable oversampling rate of between 4× and 32× of the baud rate clock for sampling. The receiver starts by taking logic level samples at the oversampling rate times the baud rate to search for a falling edge on the RXD serial data input pin. A falling edge is defined as a logic 0 sample after three consecutive logic 1 samples. The oversampling baud rate clock divides the bit time into 4 to 32 segments from 1 to OSR (where OSR is the configured oversampling ratio). When a falling edge is located, three more samples are taken at (OSR/2), (OSR/2)+1, and (OSR/2)+2 to make sure this was a real start bit and not merely noise. If at least two of these three samples are 0, the receiver assumes it is synchronized to a received character. If another falling edge is detected before the receiver is considered synchronized, the receiver restarts the sampling from the first segment.

The receiver then samples each bit time, including the start and stop bits, at (OSR/2), (OSR/2)+1, and (OSR/2)+2 to determine the logic level for that bit. The logic level is interpreted to be that of the majority of the samples taken during the bit time. If any sample in any bit time, including the start and stop bits, in a character frame fails to agree with the logic level for that bit, the noise flag (LPUART_STAT[NF]) is set when the received character is transferred to the receive data buffer.

When the LPUART receiver is configured to sample on both edges of the baud rate clock, the number of segments in each received bit is effectively doubled (from 1 to OSR×2). The start and data bits are then sampled at OSR, OSR+1 and OSR+2. Sampling on both edges of the clock must be enabled for oversampling rates of 4× to 7× and is optional for higher oversampling rates.

The falling edge detection logic continuously looks for falling edges. If an edge is detected, the sample clock is resynchronized to bit times (unless resynchronization has been disabled). This improves the reliability of the receiver in the presence of noise or mismatched baud rates. It does not improve worst case analysis because some characters do not have any extra falling edges anywhere in the character frame.

In the case of a framing error, provided the received character was not a break character, the sampling logic that searches for a falling edge is filled with three logic 1 samples so that a new start bit can be detected almost immediately.

46.4.3.2 Receiver wakeup operation

Receiver wakeup and receiver address matching is a hardware mechanism that allows an LPUART receiver to ignore the characters in a message intended for a different receiver.

During receiver wakeup, all receivers evaluate the first character(s) of each message, and as soon as they determine the message is intended for a different receiver, they write logic 1 to the receiver wake up control bit (LPUART_CTRL[RWU]). When RWU bit and LPUART_S2[RWUID] bit are set, the status flags associated with the receiver, with the exception of the idle bit, IDLE, are inhibited from setting, thus eliminating the software overhead for handling the unimportant message characters. At the end of a message, or at the beginning of the next message, all receivers automatically force LPUART_CTRL[RWU] to 0 so all receivers wake up in time to look at the first character(s) of the next message.

During receiver address matching, the address matching is performed in hardware and the LPUART receiver will ignore all characters that do not meet the address match requirements.

RWU	MA1 MA2	MATCFG	WAKE:RWUID	Receiver Wakeup
0	0	X	X	Normal operation
1	0	00	00	Receiver wakeup on idle line, IDLE flag not set
1	0	00	01	Receiver wakeup on idle line, IDLE flag set

Table 46-3. Receiver Wakeup Options

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Table 46-3. Receiver Wakeup Options (continued)

RWU	MA1 MA2	MATCFG	WAKE:RWUID	Receiver Wakeup
1	0	00	10	Receiver wakeup on address mark
1	1	11	X0	Receiver wakeup on data match
0	1	00	X0	Address mark address match, IDLE flag not set for discarded characters
0	1	00	X1	Address mark address match, IDLE flag set for discarded characters
0	1	01	X0	Idle line address match
0	1	10	X0	Address match on and address match off, IDLE flag not set for discarded characters
0	1	10	X1	Address match on and address match off, IDLE flag set for discarded characters

46.4.3.2.1 Idle-line wakeup

When wake is cleared, the receiver is configured for idle-line wakeup. In this mode, LPUART_CTRL[RWU] is cleared automatically when the receiver detects a full character time of the idle-line level. The LPUART_CTRL[M], LPUART_CTRL[M7] and LPUART_BAUD[M10] control bit selects 7-bit to 10-bit data mode and the LPUART_BAUD[SBNS] bit selects 1-bit or 2-bit stop bit number that determines how many bit times of idle are needed to constitute a full character time, 9 to 13 bit times because of the start and stop bits.

When LPUART_CTRL[RWU] is one and LPUART_STAT[RWUID] is zero, the idle condition that wakes up the receiver does not set the LPUART_STAT[IDLE] flag. The receiver wakes up and waits for the first data character of the next message that sets the LPUART_STAT[RDRF] flag and generates an interrupt if enabled. When LPUART_STAT[RWUID] is one, any idle condition sets the LPUART_STAT[IDLE] flag and generates an interrupt if enabled, regardless of whether LPUART_CTRL[RWU] is zero or one.

The idle-line type (LPUART_CTRL[ILT]) control bit selects one of two ways to detect an idle line. When LPUART_CTRL[ILT] is cleared, the idle bit counter starts after the start bit so the stop bit and any logic 1s at the end of a character count toward the full

character time of idle. When LPUART_CTRL[ILT] is set, the idle bit counter does not start until after the stop bit time, so the idle detection is not affected by the data in the last character of the previous message.

46.4.3.2.2 Address-mark wakeup

When LPUART_CTRL[WAKE] is set, the receiver is configured for address-mark wakeup. In this mode, LPUART_CTRL[RWU] is cleared automatically when the receiver detects a logic 1 in the most significant bit of a received character.

Address-mark wakeup allows messages to contain idle characters, but requires the MSB be reserved for use in address frames. The logic 1 in the MSB of an address frame clears the LPUART_CTRL[RWU] bit before the stop bits are received and sets the LPUART_STAT[RDRF] flag. In this case, the character with the MSB set is received even though the receiver was sleeping during most of this character time.

46.4.3.2.3 Data match wakeup

When LPUART_CTRL[RWU] is set and LPUART_BAUD[MATCFG] equals 11, the receiver is configured for data match wakeup. In this mode, LPUART_CTRL[RWU] is cleared automatically when the receiver detects a character that matches MATCH[MA1] field when BAUD[MAEN1] is set, or that matches MATCH[MA2] when BAUD[MAEN2] is set.

46.4.3.2.4 Address Match operation

Address match operation is enabled when the LPUART_BAUD[MAEN1] or LPUART_BAUD[MAEN2] bit is set and LPUART_BAUD[MATCFG] is equal to 00. In this function, a character received by the RXD pin with a logic 1 in the bit position immediately preceding the stop bit is considered an address and is compared with the associated MATCH[MA1] or MATCH[MA2] field. The character is only transferred to the receive buffer, and LPUART_STAT[RDRF] is set, if the comparison matches. All subsequent characters received with a logic 0 in the bit position immediately preceding the stop bit are considered to be data associated with the address and are transferred to the receive data buffer. If no marked address match occurs then no transfer is made to the receive data buffer, and all following characters with logic zero in the bit position immediately preceding the stop bit are also discarded. If both the LPUART_BAUD[MAEN1] and LPUART_BAUD[MAEN2] bits are negated, the receiver operates normally and all data received is transferred to the receive data buffer.

Address match operation functions in the same way for both MATCH[MA1] and MATCH[MA2] fields.

NXP Semiconductors

1213

Functional description

- If only one of LPUART_BAUD[MAEN1] and LPUART_BAUD[MAEN2] is asserted, a marked address is compared only with the associated match register and data is transferred to the receive data buffer only on a match.
- If LPUART_BAUD[MAEN1] and LPUART_BAUD[MAEN2] are asserted, a marked address is compared with both match registers and data is transferred only on a match with either register.

46.4.3.2.5 Idle Match operation

Idle match operation is enabled when the LPUART_BAUD[MAEN1] or LPUART_BAUD[MAEN2] bit is set and LPUART_BAUD[MATCFG] is equal to 01. In this function, the first character received by the RXD pin after an idle line condition is considered an address and is compared with the associated MA1 or MA2 register. The character is only transferred to the receive buffer, and LPUART_STAT[RDRF] is set, if the comparison matches. All subsequent characters are considered to be data associated with the address and are transferred to the receive data buffer until the next idle line condition is detected. If no address match occurs then no transfer is made to the receive data buffer, and all following frames until the next idle condition are also discarded. If both the LPUART_BAUD[MAEN1] and LPUART_BAUD[MAEN2] bits are negated, the receiver operates normally and all data received is transferred to the receive data buffer.

Idle match operation functions in the same way for both MA1 and MA2 registers.

- If only one of LPUART_BAUD[MAEN1] and LPUART_BAUD[MAEN2] is asserted, the first character after an idle line is compared only with the associated match register and data is transferred to the receive data buffer only on a match.
- If LPUART_BAUD[MAEN1] and LPUART_BAUD[MAEN2] are asserted, the first character after an idle line is compared with both match registers and data is transferred only on a match with either register.

46.4.3.2.6 Match On Match Off operation

Match on, match off operation is enabled when both LPUART_BAUD[MAEN1] and LPUART_BAUD[MAEN2] are set and LPUART_BAUD[MATCFG] is equal to 10. In this function, a character received by the RXD pin that matches MATCH[MA1] is received and transferred to the receive buffer, and LPUART_STAT[RDRF] is set. All subsequent characters are considered to be data and are also transferred to the receive data buffer, until a character is received that matches MATCH[MA2] register. The character that matches MATCH[MA2] and all following characters are discarded, this

continues until another character that matches MATCH[MA1] is received. If both the LPUART_BAUD[MAEN1] and LPUART_BAUD[MAEN2] bits are negated, the receiver operates normally and all data received is transferred to the receive data buffer.

Match on, match off operation requires both LPUART BAUD[MAEN1] and LPUART BAUD[MAEN2] to be asserted.

Hardware flow control 46.4.3.3

To support hardware flow control, the receiver can be programmed to automatically deassert and assert RTS B.

- RTS_B remains asserted until the transfer is complete, even if the transmitter is disabled midway through a data transfer. See Transceiver driver enable using RTS_B for more details.
- If the receiver request-to-send functionality is enabled, the receiver automatically deasserts RTS B if the number of characters in the receiver data register is full or a start bit is detected that will cause the receiver data register to be full.
- The receiver asserts RTS_B when the number of characters in the receiver data register is not full and has not detected a start bit that will cause the receiver data register to be full. It is not affected if STAT[RDRF] is asserted.
- Even if RTS B is deasserted, the receiver continues to receive characters until the receiver data buffer is overrun.
- If the receiver request-to-send functionality is disabled, the receiver RTS B remains deasserted.

46.4.3.4 Infrared decoder

The infrared decoder converts the received character from the IrDA format to the NRZ format used by the receiver. It also has a OSR oversampling baud rate clock counter that filters noise and indicates when a 1 is received.

Start bit detection 46.4.3.4.1

When STAT[RXINV] is cleared, the first falling edge of the received character corresponds to the start bit. The infrared decoder resets its counter. At this time, the receiver also begins its start bit detection process. After the start bit is detected, the

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

1215

Functional description

receiver synchronizes its bit times to this start bit time. For the rest of the character reception, the infrared decoder's counter and the receiver's bit time counter count independently from each other.

46.4.3.4.2 Noise filtering

Any further rising edges detected during the first half of the infrared decoder counter are ignored by the decoder. Any pulses less than one oversampling baud clock can be undetected by it regardless of whether it is seen in the first or second half of the count.

46.4.3.4.3 Low-bit detection

During the second half of the decoder count, a rising edge is decoded as a 0, which is sent to the receiver. The decoder counter is also reset.

46.4.3.4.4 High-bit detection

At OSR oversampling baud rate clocks after the previous rising edge, if a rising edge is not seen, then the decoder sends a 1 to the receiver.

If the next bit is a 0, which arrives late, then a low-bit is detected according to Low-bit detection. The value sent to the receiver is changed from 1 to a 0. Then, if a noise pulse occurs outside the receiver's bit time sampling period, then the delay of a 0 is not recorded as noise.

46.4.4 Additional LPUART functions

The following sections describe additional LPUART functions.

46.4.4.1 Data Modes

The LPUART transmitter and receiver can be configured to operate in 7-bit data mode by setting LPUART_CTRL[M7], 9-bit data mode by setting the LPUART_CTRL[M] or 10-bit data mode by setting LPUART_CTRL[M10]. In 9-bit mode, there is a ninth data bit in 10-bit mode there is a tenth data bit. For the transmit data buffer, these bits are stored in LPUART_CTRL[T8] and LPUART_CTRL[T9]. For the receiver, these bits are held in LPUART_CTRL[R8] and LPUART_CTRL[R9]. They are also accessible via 16-bit or 32-bit accesses to the LPUART_DATA register.

For coherent 8-bit writes to the transmit data buffer, write to LPUART_CTRL[T8] and LPUART_CTRL[T9] before writing to LPUART_DATA[7:0]. For 16-bit and 32-bit writes to the LPUART_DATA register all 10 transmit bits are written to the transmit data buffer at the same time.

If the bit values to be transmitted as the ninth and tenth bit of a new character are the same as for the previous character, it is not necessary to write to LPUART_CTRL[T8] and LPUART_CTRL[T9] again. When data is transferred from the transmit data buffer to the transmit shifter, the value in LPUART_CTRL[T8] and LPUART_CTRL[T9] is copied at the same time data is transferred from LPUART_DATA[7:0] to the shifter.

The 9-bit data mode is typically used with parity to allow eight bits of data plus the parity in the ninth bit, or it is used with address-mark wakeup so the ninth data bit can serve as the wakeup bit. The 10-bit data mode is typically used with parity and address-mark wakeup so the ninth data bit can serve as the wakeup bit and the tenth bit as the parity bit. In custom protocols, the ninth and/or tenth bits can also serve as software-controlled markers.

46.4.4.2 Idle length

An idle character is a character where the start bit, all data bits and stop bits are in the mark postion. The CTRL[ILT] register can be configured to start detecting an idle character from the previous start bit (any data bits and stop bits count towards the idle character detection) or from the previous stop bit.

The number of idle characters that must be received before an idle line condition is detected can also be configured using the CTRL[IDLECFG] field. This field configures the number of idle characters that must be received before the STAT[IDLE] flag is set, the STAT[RAF] flag is cleared and the DATA[IDLINE] flag is set with the next received character.

Idle-line wakeup and idle match operation are also affected by the CTRL[IDLECFG] field. When address match or match on/off operation is enabled, setting the STAT[RWUID] bit will cause any discarded characters to be treated as if they were idle characters.

46.4.4.3 Loop mode

When LPUART_CTRL[LOOPS] is set, the LPUART_CTRL[RSRC] bit in the same register chooses between loop mode (LPUART_CTRL[RSRC] = 0) or single-wire mode (LPUART_CTRL[RSRC] = 1). Loop mode is sometimes used to check software,

Functional description

independent of connections in the external system, to help isolate system problems. In this mode, the transmitter output is internally connected to the receiver input and the RXD pin is not used by the LPUART.

46.4.4.4 Single-wire operation

When LPUART_CTRL[LOOPS] is set, the RSRC bit in the same register chooses between loop mode (LPUART_CTRL[RSRC] = 0) or single-wire mode (LPUART_CTRL[RSRC] = 1). Single-wire mode implements a half-duplex serial connection. The receiver is internally connected to the transmitter output and to the TXD pin (the RXD pin is not used).

In single-wire mode, the LPUART_CTRL[TXDIR] bit controls the direction of serial data on the TXD pin. When LPUART_CTRL[TXDIR] is cleared, the TXD pin is an input to the receiver and the transmitter is temporarily disconnected from the TXD pin so an external device can send serial data to the receiver. When LPUART_CTRL[TXDIR] is set, the TXD pin is an output driven by the transmitter, the internal loop back connection is disabled, and as a result the receiver cannot receive characters that are sent out by the transmitter.

46.4.5 Infrared interface

The LPUART provides the capability of transmitting narrow pulses to an IR LED and receiving narrow pulses and transforming them to serial bits, which are sent to the LPUART. The IrDA physical layer specification defines a half-duplex infrared communication link for exchanging data. The full standard includes data rates up to 16 Mbits/s. This design covers data rates only between 2.4 kbits/s and 115.2 kbits/s.

The LPUART has an infrared transmit encoder and receive decoder. The LPUART transmits serial bits of data that are encoded by the infrared submodule to transmit a narrow pulse for every zero bit. No pulse is transmitted for every one bit. When receiving data, the IR pulses are detected using an IR photo diode and transformed to CMOS levels by the IR receive decoder, external from the LPUART. The narrow pulses are then stretched by the infrared receive decoder to get back to a serial bit stream to be received by the LPUART. The polarity of transmitted pulses and expected receive pulses can be inverted so that a direct connection can be made to external IrDA transceiver modules that use active high pulses.

The infrared submodule receives its clock sources from the LPUART. One of these two clocks are selected in the infrared submodule to generate either 1/OSR, 2/OSR, 3/OSR, or 4/OSR narrow pulses during transmission.

Infrared transmit encoder 46.4.5.1

The infrared transmit encoder converts serial bits of data from transmit shift register to the TXD signal. A narrow pulse is transmitted for a zero bit and no pulse for a one bit. The narrow pulse is sent at the start of the bit with a duration of 1/OSR, 2/OSR, 3/OSR, or 4/OSR of a bit time. A narrow low pulse is transmitted for a zero bit when LPUART_CTRL[TXINV] is cleared, while a narrow high pulse is transmitted for a zero bit when LPUART_CTRL[TXINV] is set.

Infrared receive decoder 46.4.5.2

The infrared receive block converts data from the RXD signal to the receive shift register. A narrow pulse is expected for each zero received and no pulse is expected for each one received. A narrow low pulse is expected for a zero bit when LPUART_STAT[RXINV] is cleared, while a narrow high pulse is expected for a zero bit when LPUART_STAT[RXINV] is set. This receive decoder meets the edge jitter requirement as defined by the IrDA serial infrared physical layer specification.

Interrupts and status flags 46.4.6

The LPUART transmitter has two status flags that can optionally generate hardware interrupt requests. Transmit data register empty LPUART_STAT[TDRE]) indicates when there is room in the transmit data buffer to write another transmit character to LPUART_DATA. If the transmit interrupt enable LPUART_CTRL[TIE]) bit is set, a hardware interrupt is requested when LPUART_STAT[TDRE] is set. Transmit complete (LPUART_STAT[TC]) indicates that the transmitter is finished transmitting all data, preamble, and break characters and is idle with TXD at the inactive level. This flag is often used in systems with modems to determine when it is safe to turn off the modem. If the transmit complete interrupt enable (LPUART_CTRL[TCIE]) bit is set, a hardware interrupt is requested when LPUART_STAT[TC] is set. Instead of hardware interrupts, software polling may be used to monitor the LPUART_STAT[TDRE] and LPUART_STAT[TC] status flags if the corresponding LPUART_CTRL[TIE] or LPUART_CTRL[TCIE] local interrupt masks are cleared.

When a program detects that the receive data register is full (LPUART_STAT[RDRF] = 1), it gets the data from the receive data register by reading LPUART_DATA. The LPUART STAT[RDRF] flag is cleared by reading LPUART DATA.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

1219

Functional description

The IDLE status flag includes logic that prevents it from getting set repeatedly when the RXD line remains idle for an extended period of time. IDLE is cleared by writing 1 to the LPUART_STAT[IDLE] flag. After LPUART_STAT[IDLE] has been cleared, it cannot become set again until the receiver has received at least one new character and has set LPUART_STAT[RDRF].

If the associated error was detected in the received character that caused LPUART_STAT[RDRF] to be set, the error flags - noise flag (LPUART_STAT[NF]), framing error (LPUART_STAT[FE]), and parity error flag (LPUART_STAT[PF]) - are set at the same time as LPUART_STAT[RDRF]. These flags are not set in overrun cases.

If LPUART_STAT[RDRF] was already set when a new character is ready to be transferred from the receive shifter to the receive data buffer, the overrun (LPUART_STAT[OR]) flag is set instead of the data along with any associated NF, FE, or PF condition is lost.

If the received character matches the contents of MATCH[MA1] and/or MATCH[MA2] then the LPUART_STAT[MA1F] and/or LPUART_STAT[MA2F] flags are set at the same time that LPUART_STAT[RDRF] is set.

At any time, an active edge on the RXD serial data input pin causes the LPUART_STAT[RXEDGIF] flag to set. The LPUART_STAT[RXEDGIF] flag is cleared by writing a 1 to it. This function depends on the receiver being enabled (LPUART_CTRL[RE] = 1).

Chapter 47 Flexible I/O (FlexIO)

47.1 Chip-specific Information for this Module

47.1.1 Instantiation Information

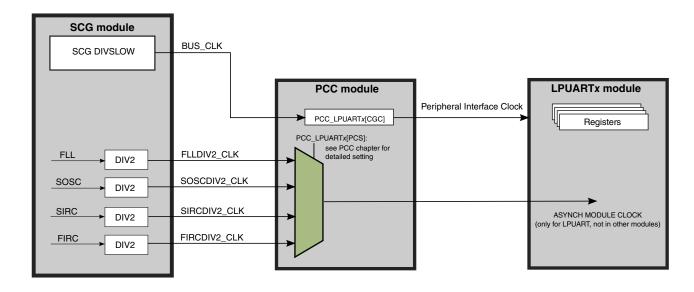
Table 47-1. FlexIO Configuration

	Timers	Shifters	Pins
Number	4	4	8

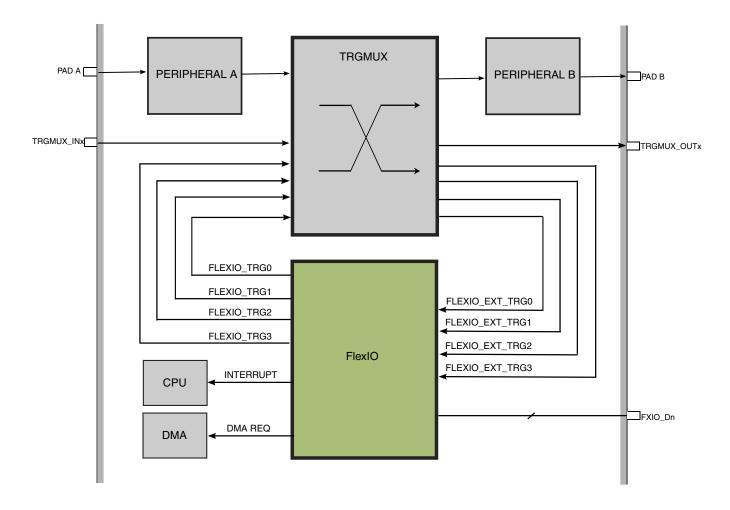
47.1.2 FlexIO Clocking Information

The FlexIO blocks are clocked from a single FlexIO clock that can be selected from OSCCLK, SCGIRCLK, SCGFIRCLK, or SCGFCLK. The selected source is controlled by the PCC_FLEXIO register in the PCC module. You have to select a clock for FlexIO and enable the clock gate before accessing any of the FlexIO registers.

Peripheral Clocking - LPUART Note: this example figure also applies similarly to the clocking for LPSPI, LPI2C, and LPIT.



47.1.3 Inter-connectivity Information



FlexIO has a selectable trigger input source controlled by FlexIO_TIMCTLn[TRGSEL] (4-bit field) to use for starting the counter and/or reloading the counter. The trigger signal is from the FlexIO module itself which is called internal triggers, or from other modules which is called external triggers. The external triggers selection is controlled by the TRGMUX_FLEXIO register in the TRGMUX module. For this device, the external triggers can be selected from any of the TRGMUX trigger sources.

47.2 Introduction

47.2.1 Overview

The FlexIO is a highly configurable module providing a wide range of functionality including:

- Emulation of a variety of serial communication protocols
- Flexible 16-bit timers with support for a variety of trigger, reset, enable and disable conditions

These functions are provided by the FlexIO while adhering to the following key objectives:

- Low software/CPU overhead: less overhead than software bit-banging, more overhead than dedicated peripheral IP.
- Area/Power efficient implementation: more efficient than integrating multiple peripherals for each desired protocol.

47.2.2 Features

The FlexIO module is capable of supporting a wide range of protocols including, but not limited to:

- UART
- I2C
- SPI
- I2S
- PWM/Waveform generation

The following key features are provided:

- Array of 32-bit shift registers with transmit, receive and data match modes
- Double buffered shifter operation for continuous data transfer
- Shifter concatenation to support large transfer sizes
- Automatic start/stop bit generation
- Interrupt, DMA or polled transmit/receive operation
- Programmable baud rates independent of bus clock frequency, with support for asynchronous operation during stop modes
- Highly flexible 16-bit timers with support for a variety of internal or external trigger, reset, enable and disable conditions

Block Diagram 47.2.3

The following diagram gives a high-level overview of the configuration of FlexIO timers and shifters.

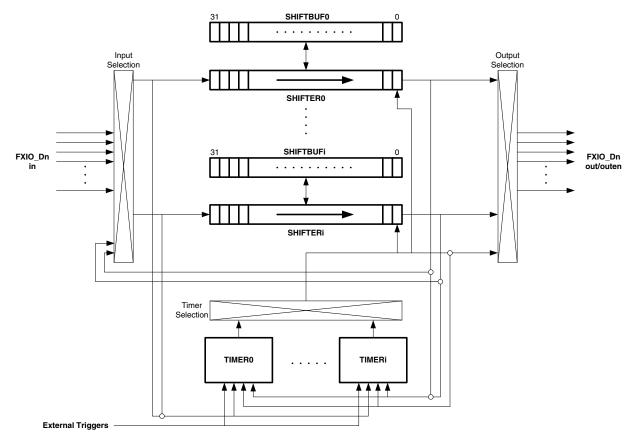


Figure 47-1. FlexIO block diagram

Modes of operation 47.2.4

The FlexIO module supports the chip modes described in the following table.

Table 47-2. Chip modes supported by the FlexIO module

Chip mode	FlexIO Operation
Run	Normal operation
Stop/Wait	Can continue operating provided the Doze Enable bit (CTRL[DOZEN]) is set and the FlexIO is using an external or internal clock source which remains operating during stop/wait modes.
Debug	Can continue operating provided the Debug Enable bit (CTRL[DBGE]) is set.

47.2.5 FlexIO Signal Descriptions

Signal	Description	I/O
	Bidirectional FlexIO Shifter and Timer pin inputs/outputs	I/O

47.3 Memory Map/Register Definition

This section includes the memory map and register definition.

NOTE

The FlexIO functional clock must be enabled before accessing any FlexIO registers. Accessing FlexIO registers with FlexIO functional clock disabled will result in transfer error.

FLEXIO memory map

Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page
4005_A000	Version ID Register (FLEXIO_VERID)	32	R	0101_0000h	47.3.1/1228
4005_A004	Parameter Register (FLEXIO_PARAM)	32	R	See section	47.3.2/1229
4005_A008	FlexIO Control Register (FLEXIO_CTRL)	32	R/W	0000_0000h	47.3.3/1229
4005_A00C	Pin State Register (FLEXIO_PIN)	32	R	0000_0000h	47.3.4/1230
4005_A010	Shifter Status Register (FLEXIO_SHIFTSTAT)	32	w1c	0000_0000h	47.3.5/1231
4005_A014	Shifter Error Register (FLEXIO_SHIFTERR)	32	w1c	0000_0000h	47.3.6/1232
4005_A018	Timer Status Register (FLEXIO_TIMSTAT)	32	w1c	0000_0000h	47.3.7/1232
4005_A020	Shifter Status Interrupt Enable (FLEXIO_SHIFTSIEN)	32	R/W	0000_0000h	47.3.8/1233
4005_A024	Shifter Error Interrupt Enable (FLEXIO_SHIFTEIEN)	32	R/W	0000_0000h	47.3.9/1234
4005_A028	Timer Interrupt Enable Register (FLEXIO_TIMIEN)	32	R/W	0000_0000h	47.3.10/ 1234
4005_A030	Shifter Status DMA Enable (FLEXIO_SHIFTSDEN)	32	R/W	0000_0000h	47.3.11/ 1235
4005_A080	Shifter Control N Register (FLEXIO_SHIFTCTL0)	32	R/W	0000_0000h	47.3.12/ 1235
4005_A084	Shifter Control N Register (FLEXIO_SHIFTCTL1)	32	R/W	0000_0000h	47.3.12/ 1235
4005_A088	Shifter Control N Register (FLEXIO_SHIFTCTL2)	32	R/W	0000_0000h	47.3.12/ 1235
4005_A08C	Shifter Control N Register (FLEXIO_SHIFTCTL3)	32	R/W	0000_0000h	47.3.12/ 1235
4005_A100	Shifter Configuration N Register (FLEXIO_SHIFTCFG0)	32	R/W	0000_0000h	47.3.13/ 1237

Table continues on the next page...

FLEXIO memory map (continued)

Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page
4005_A104	Shifter Configuration N Register (FLEXIO_SHIFTCFG1)	32	R/W	0000_0000h	47.3.13/ 1237
4005_A108	Shifter Configuration N Register (FLEXIO_SHIFTCFG2)	32	R/W	0000_0000h	47.3.13/ 1237
4005_A10C	Shifter Configuration N Register (FLEXIO_SHIFTCFG3)	32	R/W	0000_0000h	47.3.13/ 1237
4005_A200	Shifter Buffer N Register (FLEXIO_SHIFTBUF0)	32	R/W	0000_0000h	47.3.14/ 1238
4005_A204	Shifter Buffer N Register (FLEXIO_SHIFTBUF1)	32	R/W	0000_0000h	47.3.14/ 1238
4005_A208	Shifter Buffer N Register (FLEXIO_SHIFTBUF2)	32	R/W	0000_0000h	47.3.14/ 1238
4005_A20C	Shifter Buffer N Register (FLEXIO_SHIFTBUF3)	32	R/W	0000_0000h	47.3.14/ 1238
4005_A280	Shifter Buffer N Bit Swapped Register (FLEXIO_SHIFTBUFBIS0)	32	R/W	0000_0000h	47.3.15/ 1239
4005_A284	Shifter Buffer N Bit Swapped Register (FLEXIO_SHIFTBUFBIS1)	32	R/W	0000_0000h	47.3.15/ 1239
4005_A288	Shifter Buffer N Bit Swapped Register (FLEXIO_SHIFTBUFBIS2)	32	R/W	0000_0000h	47.3.15/ 1239
4005_A28C	Shifter Buffer N Bit Swapped Register (FLEXIO_SHIFTBUFBIS3)	32	R/W	0000_0000h	47.3.15/ 1239
4005_A300	Shifter Buffer N Byte Swapped Register (FLEXIO_SHIFTBUFBYS0)	32	R/W	0000_0000h	47.3.16/ 1239
4005_A304	Shifter Buffer N Byte Swapped Register (FLEXIO_SHIFTBUFBYS1)	32	R/W	0000_0000h	47.3.16/ 1239
4005_A308	Shifter Buffer N Byte Swapped Register (FLEXIO_SHIFTBUFBYS2)	32	R/W	0000_0000h	47.3.16/ 1239
4005_A30C	Shifter Buffer N Byte Swapped Register (FLEXIO_SHIFTBUFBYS3)	32	R/W	0000_0000h	47.3.16/ 1239
4005_A380	Shifter Buffer N Bit Byte Swapped Register (FLEXIO_SHIFTBUFBBS0)	32	R/W	0000_0000h	47.3.17/ 1240
4005_A384	Shifter Buffer N Bit Byte Swapped Register (FLEXIO_SHIFTBUFBBS1)	32	R/W	0000_0000h	47.3.17/ 1240
4005_A388	Shifter Buffer N Bit Byte Swapped Register (FLEXIO_SHIFTBUFBBS2)	32	R/W	0000_0000h	47.3.17/ 1240
4005_A38C	Shifter Buffer N Bit Byte Swapped Register (FLEXIO_SHIFTBUFBBS3)	32	R/W	0000_0000h	47.3.17/ 1240
4005_A400	Timer Control N Register (FLEXIO_TIMCTL0)	32	R/W	0000_0000h	47.3.18/ 1240
4005_A404	Timer Control N Register (FLEXIO_TIMCTL1)	32	R/W	0000_0000h	47.3.18/ 1240
4005_A408	Timer Control N Register (FLEXIO_TIMCTL2)	32	R/W	0000_0000h	47.3.18/ 1240

Table continues on the next page...

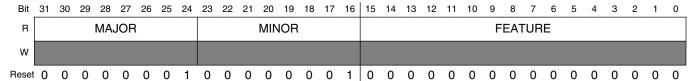
Memory Map/Register Definition

FLEXIO memory map (continued)

Absolute address (hex)	Register name	Width (in bits)	Access	Reset value	Section/ page
4005_A40C	Timer Control N Register (FLEXIO_TIMCTL3)	32	R/W	0000_0000h	47.3.18/ 1240
4005_A480	Timer Configuration N Register (FLEXIO_TIMCFG0)	32	R/W	0000_0000h	47.3.19/ 1242
4005_A484	Timer Configuration N Register (FLEXIO_TIMCFG1)	32	R/W	0000_0000h	47.3.19/ 1242
4005_A488	Timer Configuration N Register (FLEXIO_TIMCFG2)	32	R/W	0000_0000h	47.3.19/ 1242
4005_A48C	Timer Configuration N Register (FLEXIO_TIMCFG3)	32	R/W	0000_0000h	47.3.19/ 1242
4005_A500	Timer Compare N Register (FLEXIO_TIMCMP0)	32	R/W	0000_0000h	47.3.20/ 1244
4005_A504	Timer Compare N Register (FLEXIO_TIMCMP1)	32	R/W	0000_0000h	47.3.20/ 1244
4005_A508	Timer Compare N Register (FLEXIO_TIMCMP2)	32	R/W	0000_0000h	47.3.20/ 1244
4005_A50C	Timer Compare N Register (FLEXIO_TIMCMP3)	32	R/W	0000_0000h	47.3.20/ 1244

47.3.1 Version ID Register (FLEXIO_VERID)

Address: 4005_A000h base + 0h offset = 4005_A000h



FLEXIO_VERID field descriptions

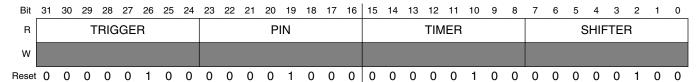
Field	Description	
31–24 MAJOR	Major Version Number	
	This read only field returns the major version number for the module specification.	
23–16 MINOR	Minor Version Number	
	This read only field returns the minor version number for the module specification.	
FEATURE	Feature Specification Number	
	This read only field returns the feature set number.	
	0x0000 Standard features implemented.	
	0x0001 Supports state, logic and parallel modes.	

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

47.3.2 Parameter Register (FLEXIO_PARAM)

•

Address: 4005_A000h base + 4h offset = 4005_A004h



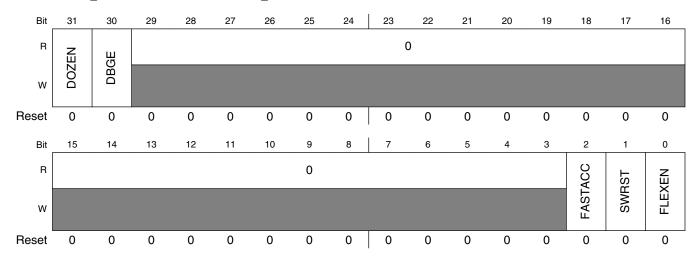
FLEXIO_PARAM field descriptions

Field	Description
31–24 TRIGGER	Trigger Number
midden	Number of external triggers implemented.
23–16 PIN	Pin Number
	Number of Pins implemented.
15–8 TIMER	Timer Number
	Number of Timers implemented.
SHIFTER	Shifter Number
	Number of Shifters implemented.

47.3.3 FlexIO Control Register (FLEXIO_CTRL)

.

Address: 4005_A000h base + 8h offset = 4005_A008h



Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

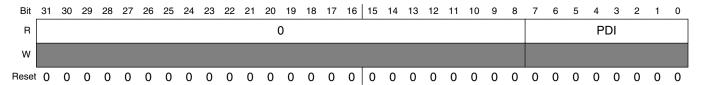
Memory Map/Register Definition

FLEXIO_CTRL field descriptions

Field	Description
31 DOZEN	Doze Enable Disables FlexIO operation in Doze modes. This field is ignored and the FlexIO always disabled in low-leakage stop modes. O FlexIO enabled in Doze modes. 1 FlexIO disabled in Doze modes.
30 DBGE	Debug Enable Enables FlexIO operation in Debug mode. 0 FlexIO is disabled in debug modes. 1 FlexIO is enabled in debug modes
29–3 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
2 FASTACC	Fast Access Enables fast register accesses to FlexIO registers, but requires the FlexIO clock to be at least twice the frequency of the bus clock. O Configures for normal register accesses to FlexIO Configures for fast register accesses to FlexIO
1 SWRST	Software Reset The FlexIO Control Register is not affected by the software reset, all other logic in the FlexIO is affected by the software reset and register accesses are ignored until this bit is cleared. This register bit will remain set until cleared by software, and the reset has cleared in the FlexIO clock domain. O Software reset is disabled Software reset is enabled, all FlexIO registers except the Control Register are reset.
0 FLEXEN	FlexIO Enable 0 FlexIO module is disabled. 1 FlexIO module is enabled.

47.3.4 Pin State Register (FLEXIO_PIN)

Address: 4005_A000h base + Ch offset = 4005_A00Ch



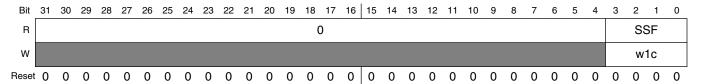
FLEXIO_PIN field descriptions

Field	Description
31–8 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
	·
PDI	Pin Data Input
	Returns the input data on each of the FlexIO pins.

47.3.5 Shifter Status Register (FLEXIO_SHIFTSTAT)

•

Address: 4005_A000h base + 10h offset = 4005_A010h



FLEXIO_SHIFTSTAT field descriptions

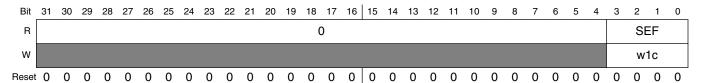
Field	Description
31–4 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
SSF	Shifter Status Flag
	The shifter status flag is updated when one of the following events occurs:
	For SMOD=Receive, the status flag is set when SHIFTBUF has been loaded with data from Shifter (SHIFTBUF is full), and the status flag is cleared when SHIFTBUF register is read.
	For SMOD=Transmit, the status flag is set when SHIFTBUF data has been transferred to the Shifter (SHIFTBUF is empty) or when initially configured for SMOD=Transmit, and the status flag is cleared when the SHIFTBUF register is written.
	For SMOD=Match Store, the status flag is set when a match has occured between SHIFTBUF and Shifter, and the status flag is cleared when the SHIFTBUF register is read.
	For SMOD=Match Continuous, returns the current match result between the SHIFTBUF and Shifter.
	The status flag can also be cleared by writing a logic one to the flag for all modes except Match Continuous.
	0 Status flag is clear1 Status flag is set

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

47.3.6 Shifter Error Register (FLEXIO_SHIFTERR)

•

Address: 4005_A000h base + 14h offset = 4005_A014h

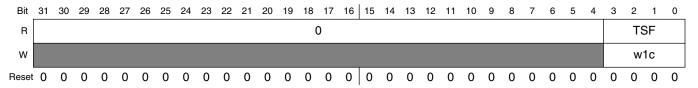


FLEXIO_SHIFTERR field descriptions

Field	Description
31–4 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
SEF	Shifter Error Flags
	The shifter error flag is set when one of the following events occurs:
	For SMOD=Receive, indicates Shifter was ready to store new data into SHIFTBUF before the previous data was read from SHIFTBUF (SHIFTBUF Overrun), or indicates that the received start or stop bit does not match the expected value.
	For SMOD=Transmit, indicates Shifter was ready to load new data from SHIFTBUF before new data had been written into SHIFTBUF (SHIFTBUF Underrun).
	For SMOD=Match Store, indicates a match event occured before the previous match data was read from SHIFTBUF (SHIFTBUF Overrun).
	For SMOD=Match Continuous, the error flag is set when a match has occured between SHIFTBUF and Shifter.
	Can be cleared by writing logic one to the flag. For SMOD=Match Continuous, can also be cleared when the SHIFTBUF register is read.
	0 Shifter Error Flag is clear1 Shifter Error Flag is set

47.3.7 Timer Status Register (FLEXIO_TIMSTAT)

Address: 4005_A000h base + 18h offset = 4005_A018h



Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

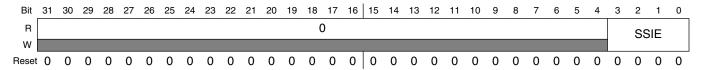
1233

FLEXIO_TIMSTAT field descriptions

Field	Description
31–4 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
TSF	Timer Status Flags The timer status flag sets depending on the timer mode, and can be cleared by writing logic one to the flag.
	In 8-bit counter mode, the timer status flag is set when the upper 8-bit counter equals zero and decrements, this also causes the counter to reload with the value in the compare register.
	In 8-bit PWM mode, the timer status flag is set when the upper 8-bit counter equals zero and decrements, this also causes the counter to reload with the value in the compare register
	In 16-bit counter mode, the timer status flag is set when the 16-bit counter equals zero and decrements, this also causes the counter to reload with the value in the compare register
	0 Timer Status Flag is clear1 Timer Status Flag is set

47.3.8 Shifter Status Interrupt Enable (FLEXIO_SHIFTSIEN)

Address: 4005_A000h base + 20h offset = 4005_A020h



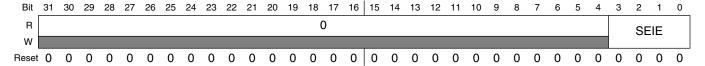
FLEXIO_SHIFTSIEN field descriptions

Field	Description
31–4 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
SSIE	Shifter Status Interrupt Enable
	Enables interrupt generation when corresponding SSF is set.
	0 Shifter Status Flag interrupt disabled
	1 Shifter Status Flag interrupt enabled

47.3.9 Shifter Error Interrupt Enable (FLEXIO_SHIFTEIEN)

•

Address: 4005_A000h base + 24h offset = 4005_A024h



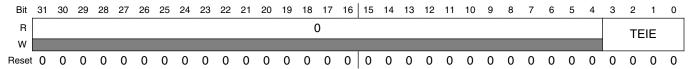
FLEXIO_SHIFTEIEN field descriptions

Field	Description
31–4	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
SEIE	Shifter Error Interrupt Enable
	Enables interrupt generation when corresponding SEF is set.
	0 Shifter Error Flag interrupt disabled
	1 Shifter Error Flag interrupt enabled

47.3.10 Timer Interrupt Enable Register (FLEXIO_TIMIEN)

.

Address: 4005_A000h base + 28h offset = 4005_A028h



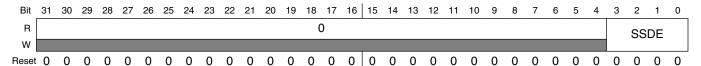
FLEXIO_TIMIEN field descriptions

Field	Description
31–4	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
TEIE	Timer Status Interrupt Enable
	Enables interrupt generation when corresponding TSF is set.
	0 Timer Status Flag interrupt is disabled
	1 Timer Status Flag interrupt is enabled

47.3.11 Shifter Status DMA Enable (FLEXIO_SHIFTSDEN)

•

Address: 4005_A000h base + 30h offset = 4005_A030h



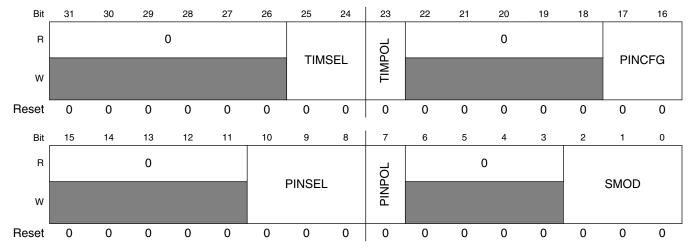
FLEXIO_SHIFTSDEN field descriptions

Field	Description
31–4 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
SSDE	Shifter Status DMA Enable Enables DMA request generation when corresponding SSF is set.
	Shifter Status Flag DMA request is disabled Shifter Status Flag DMA request is enabled

47.3.12 Shifter Control N Register (FLEXIO_SHIFTCTLn)

.

Address: 4005_A000h base + 80h offset + $(4d \times i)$, where i=0d to 3d



Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

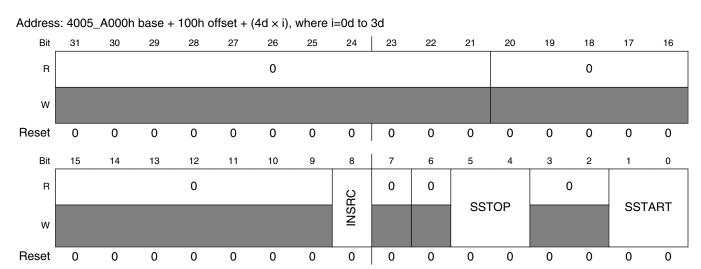
Memory Map/Register Definition

FLEXIO_SHIFTCTLn field descriptions

Field	Description
31–26 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
25–24 TIMSEL	Timer Select Selects which Timer is used for controlling the logic/shift register and generating the Shift clock.
23 TIMPOL	Timer Polarity 0 Shift on posedge of Shift clock 1 Shift on negedge of Shift clock
22–18 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
17–16 PINCFG	Shifter Pin Configuration O Shifter pin output disabled O Shifter pin open drain or bidirectional output enable Shifter pin bidirectional output data Shifter pin output
15–11 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
10-8 PINSEL	Shifter Pin Select Selects which pin is used by the Shifter input or output.
7 PINPOL	Shifter Pin Polarity O Pin is active high 1 Pin is active low
6–3 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
SMOD	Configures the mode of the Shifter. OO Disabled. OI Receive mode. Captures the current Shifter content into the SHIFTBUF on expiration of the Timer. Transmit mode. Load SHIFTBUF contents into the Shifter on expiration of the Timer. Reserved. Match Store mode. Shifter data is compared to SHIFTBUF content on expiration of the Timer. Match Continuous mode. Shifter data is continuously compared to SHIFTBUF contents.
	110 Reserved.111 Reserved.

47.3.13 Shifter Configuration N Register (FLEXIO_SHIFTCFGn)

•



FLEXIO_SHIFTCFGn field descriptions

Description
This field is reserved. This read-only field is reserved and always has the value 0.
This field is reserved. This read-only field is reserved and always has the value 0.
This field is reserved. This read-only field is reserved and always has the value 0.
Input Source Selects the input source for the shifter. 0 Pin 1 Shifter N+1 Output
This field is reserved. This read-only field is reserved and always has the value 0.
This field is reserved. This read-only field is reserved and always has the value 0.
Shifter Stop bit For SMOD=Transmit, this field allows automatic stop bit insertion if the selected timer has also enabled a stop bit. For SMOD=Receive or Match Store, this field allows automatic stop bit checking if the selected timer has also enabled a stop bit. O Stop bit disabled for transmitter/receiver/match store Reserved for transmitter/receiver/match store Transmitter outputs stop bit value 0 on store, receiver/match store sets error flag if stop bit is not 0 Transmitter outputs stop bit value 1 on store, receiver/match store sets error flag if stop bit is not 1

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Memory Map/Register Definition

FLEXIO_SHIFTCFGn field descriptions (continued)

Field	Description
3–2	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
SSTART	Shifter Start bit
	For SMOD=Transmit, this field allows automatic start bit insertion if the selected timer has also enabled a start bit.
	For SMOD=Receive or Match Store, this field allows automatic start bit checking if the selected timer has also enabled a start bit.
	00 Start bit disabled for transmitter/receiver/match store, transmitter loads data on enable
	01 Start bit disabled for transmitter/receiver/match store, transmitter loads data on first shift
	Transmitter outputs start bit value 0 before loading data on first shift, receiver/match store sets error flag if start bit is not 0
	11 Transmitter outputs start bit value 1 before loading data on first shift, receiver/match store sets error flag if start bit is not 1

47.3.14 Shifter Buffer N Register (FLEXIO_SHIFTBUFn)

•

Address: 4005_A000h base + 200h offset + $(4d \times i)$, where i=0d to 3d



FLEXIO_SHIFTBUFn field descriptions

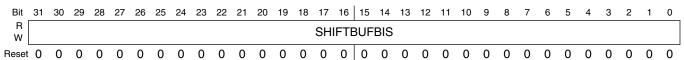
Field	Description
SHIFTBUF	Shift Buffer
	Shift buffer data is used for a variety of functions depending on the SMOD setting:
	For SMOD=Receive, Shifter data is transferred into SHIFTBUF at the expiration of Timer.
	For SMOD=Transmit, SHIFTBUF data is transferred into the Shifter before the Timer begins.
	For SMOD=Match Store/Continuous, SHIFTBUF[31:16] contains the data to be matched with the Shifter contents. The Match is checked either continuously (Match Continuous mode) or when the Timer expires (Match Store mode). SHIFTBUF[15:0] can be used to mask the match result (1=mask, 0=no mask). In Match Store mode, Shifter data [31:16] is written to SHIFTBUF[31:16] whenever a match event occurs.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

47.3.15 Shifter Buffer N Bit Swapped Register (FLEXIO_SHIFTBUFBISn)

•

Address: 4005_A000h base + 280h offset + $(4d \times i)$, where i=0d to 3d



FLEXIO_SHIFTBUFBISn field descriptions

Field	Description
SHIFTBUFBIS	Shift Buffer
	Alias to SHIFTBUF register, except reads/writes to this register are bit swapped. Reads return SHIFTBUF[0:31].

47.3.16 Shifter Buffer N Byte Swapped Register (FLEXIO_SHIFTBUFBYSn)

.

Address: 4005_A000h base + 300h offset + $(4d \times i)$, where i=0d to 3d



FLEXIO_SHIFTBUFBYSn field descriptions

Field	Description
SHIFTBUFBYS	Shift Buffer
	Alias to SHIFTBUF register, except reads/writes to this register are byte swapped. Reads return { SHIFTBUF[7:0], SHIFTBUF[15:8], SHIFTBUF[23:16], SHIFTBUF[31:24] }.

47.3.17 Shifter Buffer N Bit Byte Swapped Register (FLEXIO_SHIFTBUFBBSn)

•

Address: 4005_A000h base + 380h offset + $(4d \times i)$, where i=0d to 3d



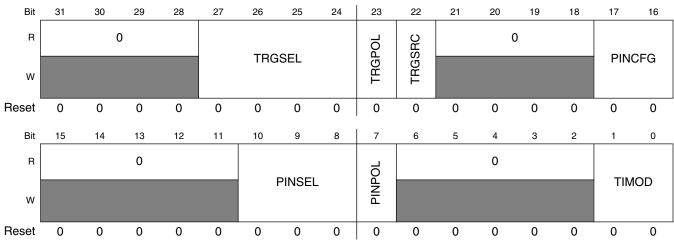
FLEXIO_SHIFTBUFBBSn field descriptions

Field	Description
SHIFTBUFBBS	Shift Buffer
	Alias to SHIFTBUF register, except reads/writes to this register are bit swapped within each byte. Reads return { SHIFTBUF[24:31], SHIFTBUF[16:23], SHIFTBUF[8:15], SHIFTBUF[0:7] }.

47.3.18 Timer Control N Register (FLEXIO_TIMCTLn)

•

Address: 4005_A000h base + 400h offset + $(4d \times i)$, where i=0d to 3d



FLEXIO_TIMCTLn field descriptions

Field	Description
	This field is reserved. This read-only field is reserved and always has the value 0.
27–24 TRGSEL	Trigger Select The valid values for TRGSEL will depend on the FLEXIO_PARAM register.

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

FLEXIO_TIMCTLn field descriptions (continued)

	Description		
	 When TRGSRC = 1, the valid values for N will depend on PIN, TIMER, SHIFTER fields in the FLEXIO_PARAM register. When TRGSRC = 0, the valid values for N will depend on TRIGGER field in FLEXIO_PARAM 		
	register.		
	Refer to the chip configuration section for external trigger selection.		
	The internal trigger selection is configured as follows:		
	{N,00} pin 2N input		
	{N,01} shifter N status flag		
	{N,10} pin 2N+1 input		
23	{N,11} timer N trigger output Trigger Polarity		
TRGPOL			
	O Trigger active high		
	1 Trigger active low		
22 TRGSRC	Trigger Source		
	0 External trigger selected		
	1 Internal trigger selected		
21–18 Reserved	This field is reserved.		
17–16	This read-only field is reserved and always has the value 0. Timer Pin Configuration		
PINCFG	Timer Fin Comiguration		
	00 Timer pin output disabled		
	O1 Timer pin open drain or bidirectional output enable		
	10 Timer pin bidirectional output data11 Timer pin output		
15–11	This field is reserved.		
Reserved	This read-only field is reserved and always has the value 0.		
10–8	Timer Pin Select		
PINSEL	Selects which pin is used by the Timer input or output.		
7	Timer Pin Polarity		
PINPOL			
	Pin is active high Pin is active low		
6–2	This field is reserved.		
Reserved	This read-only field is reserved and always has the value 0.		
TIMOD	Timer Mode		
	In 8-bit counter mode, the lower 8-bits of the counter and compare register are used to configure the bau rate of the timer shift clock and the upper 8-bits are used to configure the shifter bit count.		
	In 8-bit PWM mode, the lower 8-bits of the counter and compare register are used to configure the high period of the timer shift clock and the upper 8-bits are used to configure the low period of the timer shift clock. The shifter bit count is configured using another timer or external signal.		
	In 16-bit counter mode, the full 16-bits of the counter and compare register are used to configure either the		
	baud rate of the shift clock or the shifter bit count.		

Table continues on the next page...

Memory Map/Register Definition

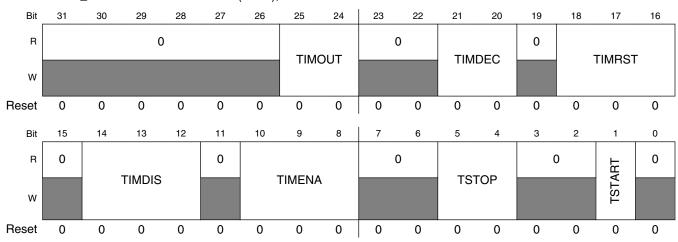
FLEXIO_TIMCTLn field descriptions (continued)

Field		Description	
	01	Dual 8-bit counters baud/bit mode.	
	10	Dual 8-bit counters PWM mode.	
	11	Single 16-bit counter mode.	

47.3.19 Timer Configuration N Register (FLEXIO_TIMCFGn)

The options to enable or disable the timer using the Timer N-1 enable or disable are reserved when N is evenly divisible by 4 (eg: Timer 0).





FLEXIO_TIMCFGn field descriptions

Field	Description	
31–26 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.	
25–24 TIMOUT	Timer Output Configures the initial state of the Timer Output and whether it is affected by the Timer reset.	
	Timer output is logic one when enabled and is not affected by timer reset Timer output is logic zero when enabled and is not affected by timer reset Timer output is logic one when enabled and on timer reset Timer output is logic zero when enabled and on timer reset	
23–22 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.	
21–20 TIMDEC	Timer Decrement Configures the source of the Timer decrement and the source of the Shift clock.	
	00 Decrement counter on FlexIO clock, Shift clock equals Timer output. 01 Decrement counter on Trigger input (both edges), Shift clock equals Timer output.	

Table continues on the next page...

FLEXIO_TIMCFGn field descriptions (continued)

Field	Description		
	10 Decrement counter on Pin input (both edges), Shift clock equals Pin input.		
	11 Decrement counter on Trigger input (both edges), Shift clock equals Trigger input.		
19	This field is reserved.		
Reserved	This read-only field is reserved and always has the value 0.		
18–16	Timer Reset		
TIMRST	Configures the condition that causes the timer counter (and optionally the timer output) to be reset. In 8 counter mode, the timer reset will only reset the lower 8-bits that configure the baud rate. In all other modes, the timer reset will reset the full 16-bits of the counter.		
	000 Timer never reset		
	001 Reserved		
	010 Timer reset on Timer Pin equal to Timer Output		
	011 Timer reset on Timer Trigger equal to Timer Output		
	100 Timer reset on Timer Pin rising edge		
	101 Reserved		
	110 Timer reset on Trigger rising edge		
	111 Timer reset on Trigger rising or falling edge		
15	This field is reserved.		
Reserved	This read-only field is reserved and always has the value 0.		
14-12 TIMDIS	Timer Disable		
	Configures the condition that causes the Timer to be disabled and stop decrementing.		
	000 Timer never disabled		
	001 Timer disabled on Timer N-1 disable		
	010 Timer disabled on Timer compare		
	011 Timer disabled on Timer compare and Trigger Low		
	100 Timer disabled on Pin rising or falling edge		
	101 Timer disabled on Pin rising or falling edge provided Trigger is high		
	110 Timer disabled on Trigger falling edge		
	111 Reserved		
11	This field is reserved.		
Reserved	This read-only field is reserved and always has the value 0.		
10–8 TIMENA	Timer Enable		
	Configures the condition that causes the Timer to be enabled and start decrementing.		
	000 Timer always enabled		
	001 Timer enabled on Timer N-1 enable		
	010 Timer enabled on Trigger high		
	011 Timer enabled on Trigger high and Pin high		
	100 Timer enabled on Pin rising edge		
	101 Timer enabled on Pin rising edge and Trigger high		
	110 Timer enabled on Trigger rising edge		
	111 Timer enabled on Trigger rising or falling edge		
7–6	This field is reserved.		
Reserved	This read-only field is reserved and always has the value 0.		

Table continues on the next page...

Memory Map/Register Definition

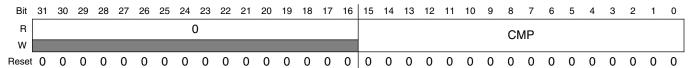
FLEXIO_TIMCFGn field descriptions (continued)

Field	Description	
5–4 TSTOP	Timer Stop Bit	
	The stop bit can be added on a timer compare (between each word) or on a timer disable. When stop bit is enabled, configured shifters will output the contents of the stop bit when the timer is disabled. When stop bit is enabled on timer disable, the timer remains disabled until the next rising edge of the shift clock. If configured for both timer compare and timer disable, only one stop bit is inserted on timer disable.	
	00 Stop bit disabled	
	01 Stop bit is enabled on timer compare	
	10 Stop bit is enabled on timer disable	
	11 Stop bit is enabled on timer compare and timer disable	
3–2	This field is reserved.	
Reserved	This read-only field is reserved and always has the value 0.	
1 TSTART	Timer Start Bit	
ISTART	When start bit is enabled, configured shifters will output the contents of the start bit when the timer is enabled and the timer counter will reload from the compare register on the first rising edge of the shift clock.	
	0 Start bit disabled	
	1 Start bit enabled	
0	This field is reserved.	
Reserved	This read-only field is reserved and always has the value 0.	

47.3.20 Timer Compare N Register (FLEXIO_TIMCMPn)

•

Address: 4005_A000h base + 500h offset + $(4d \times i)$, where i=0d to 3d



FLEXIO_TIMCMPn field descriptions

Field	Description
31–16 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
	Timer Compare Value The timer compare value is loaded into the timer counter when the timer is first enabled, when the timer is reset and when the timer decrements down to zero. In dual 8-bit counters baud/bit mode, the lower 8-bits configures the baud rate divider equal to $(CMP[7:0] + 1) * 2$. The upper 8-bits configure the number of bits in each word equal to $(CMP[15:8] + 1) / 2$. In dual 8-bit counters PWM mode, the lower 8-bits configure the high period of the output to $(CMP[7:0] + 1)$ and the upper 8-bits configure the low period of the output to $(CMP[15:8] + 1)$. In 16-bit counter mode, the compare value can be used to generate the baud rate divider (if shift clock source is timer output) to equal $(CMP[15:0] + 1) * 2$. When the shift clock source is a pin or

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

1245

FLEXIO_TIMCMPn field descriptions (continued)

Field	Description
	trigger input, the compare register is used to set the number of bits in each word equal to (CMP[15:0] + 1) / 2.

47.4 Functional description

47.4.1 Shifter operation

Shifters are responsible for buffering and shifting data into or out of the FlexIO. The timing of shift, load and store events are controlled by the Timer assigned to the Shifter via the SHIFTCTL[TIMSEL] register. The Shifters are designed to support either DMA, interrupt or polled operation. The following block diagram provides a detailed view of the Shifter microarchitecture.

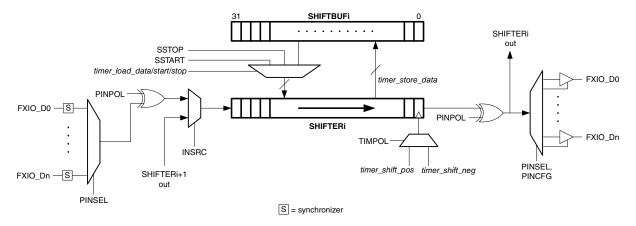


Figure 47-2. Shifter Microarchitecture

47.4.1.1 Transmit Mode

When configured for Transmit mode (SHIFTCTL[SMOD]=Transmit), the shifter will load data from the SHIFTBUF register and shift data out when a load event is signalled by the assigned Timer. An optional start/stop bit can also be automatically loaded before/after SHIFTBUF data by configuring the SHIFTCFG[SSTART], TIMCFG[TSTART] or SHIFTCFG[SSTOP], TIMCFG[TSTOP] registers in the Shifter and Timer. Note that the shifter will immediately load a stop bit when the Shifter is initially configured for Transmit mode if a stop bit is enabled.

Functional description

The Shifter Status Flag (SHIFTSTAT[SSF]) and any enabled interrupts or DMA requests will set when data has been loaded from the SHIFTBUF register into the Shifter or when the Shifter is initially configured into Transmit mode. The flag will clear when new data has been written into the SHIFTBUF register.

The Shifter Error Flag (SHIFTERR[SEF]) and any enabled interrupts will set when an attempt to load data from an empty SHIFTBUF register occurs (buffer underrun). The flag can be cleared by writing it with logic 1.

47.4.1.2 Receive Mode

When configured for Receive mode (SHIFTCTL[SMOD]=Receive), the shifter will shift data in and store data into the SHIFTBUF register when a store event is signalled by the assigned Timer. Checking for a start/stop bit can be enabled before/after shifter data is sampled by configuring the SHIFTCFG[SSTART], TIMCFG[TSTART] or SHIFTCFG[SSTOP], TIMCFG[TSTOP] registers in the Shifter and Timer.

The Shifter Status Flag (SHIFTSTAT[SSF]) and any enabled interrupts or DMA requests will set when data has been stored into the SHIFTBUF register from the Shifter. The flag will clear when the data has been read from the SHIFTBUF register.

The Shifter Error Flag (SHIFTERR[SEF]) and any enabled interrupts will set when an attempt to store data into a full SHIFTBUF register occurs (buffer overrun) or when a mismatch occurs on a start/stop bit check. The flag can be cleared by writing it with logic 1.

47.4.1.3 Match Store Mode

When configured for Match Store mode (SHIFTCTL[SMOD]=Match Store), the shifter will shift data in, check for a match result and store matched data into the SHIFTBUF register when a store event is signalled by the assigned Timer. Checking for a start/stop bit can be enabled before/after shifter data is sampled by configuring the SHIFTCFG[SSTART], TIMCFG[TSTART] or SHIFTCFG[SSTOP], TIMCFG[TSTOP] registers in the Shifter and Timer. Up to 16-bits of data can be compared using SHIFTBUF[31:16] to configure the data to be matched and SHIFTBUF[15:0] to mask the match result.

The Shifter Status Flag (SHIFTSTAT[SSF]) and any enabled interrupts or DMA requests will set when a match occurs and matched data has been stored into the SHIFTBUF register from the Shifter. The flag will clear when the matched data has been read from the SHIFTBUF register.

1247

The Shifter Error Flag (SHIFTERR[SEF]) and any enabled interrupts will set when an attempt to store matched data into a full SHIFTBUF register occurs (buffer overrun) or when a mismatch occurs on a start/stop bit check. The flag can be cleared by writing it with logic 1.

47.4.1.4 Match Continuous Mode

When configured for Match Continuous mode (SHIFTCTL[SMOD]=Match Continuous), the shifter will shift data in and continuously check for a match result whenever a shift event is signalled by the assigned Timer. Up to 16-bits of data can be compared using SHIFTBUF[31:16] to configure the data to be matched and SHIFTBUF[15:0] to mask the match result.

The Shifter Status Flag (SHIFTSTAT[SSF]) and any enabled interrupts or DMA requests will set when a match occurs. The flag will clear automatically as soon as there is no longer a match between Shifter data and SHIFTBUF register.

The Shifter Error Flag (SHIFTERR[SEF]) and any enabled interrupts will set when a match occurs. The flag will clear when there is a read from the SHIFTBUF register or it written with logic 1.

47.4.2 Timer operation

The FlexIO 16-bit timers control the loading, shifting and storing of the shift registers, the counters load the contents of the compare register and decrement down to zero on the FlexIO clock. They can perform generic timer functions such as generating a clock or select output or a PWM waveform. Timers can be configured to enable in response to a trigger, pin or shifter condition; decrement always or only on a trigger or pin edge; reset in response to a trigger or pin condition; and disable on a trigger or pin condition or on a timer compare. Timers can optionally include a start condition and/or stop condition.

Each timer operates independently, although a timer can be configured to enable or disable at the same time as the previous timer (eg: timer1 can enable or disable at the same time as timer 0) and a timer output can be used to trigger any other timer. The trigger used by each timer is configured independently and can be configured to be a timer output, shifter status flag, pin input or an external trigger input (refer to the chip configuration section for details on the external trigger connections). The trigger configuration is separate from the pin configuration, which can be configured for input, output data or output enable.

Functional description

The Timer Configuration Register (TIMCFGn) should be configured before setting the Timer Mode (TIMOD). Once the TIMOD is configured for the desired mode, when the condition configured by timer enable (TIMENA) is detected then the following events occur.

- Timer counter will load the current value of the Compare Register and start decrementing as configured by TIMDEC.
- Timer output will set depending on the TIMOUT configuration.
- Transmit shifters controlled by this timer will either output their start bit value, or load the shift register from the shift buffer and output the first bit, as configured by SSTART.

The Timer will then generate the timer output and timer shift clock depending on the TIMOD and TIMDEC fields. The shifter clock is either equal to the timer output (when TIMDEC=00 or 01) or equal to the decrement clock (when TIMDEC=10 or 11). When TIMDEC is configured to decrement from a pin or trigger, the timer will decrement on both rising and falling edges.

When the Timer is configured to reset as configured in the TIMRST field then the Timer counter will load the current value of the Compare Register again, the timer output may also be affected by the reset as configured in TIMOUT.

If the Timer start bit is enabled, the timer counter will reload with the compare register on the first rising edge of the shift clock after the timer starts decrementing. If there is no falling edge on the shift clock before the first rising edge (for example, when TIMOUT=1), a shifter that is configured to shift on falling edge and load on the first shift will not load correctly.

When configured for 8-bit counter mode, whenever the lower 8-bit counter decrements to zero the timer output will toggle, the lower 8-bit counter register will reload from the compare register and the upper 8-bit counter will decrement. For 8-bit PWM mode, the lower 8-bit counter will only decrement when the output is high and the upper 8-bit counter will only decrement when the output is low. The timer output will toggle whenever either lower or upper 8-bit counter decrements to zero.

When the timer decrements to zero, a compare event occurs depending on the timer mode. For 8-bit counter or PWM modes, both halves of the counter must equal zero and the upper half must decrement for the timer compare event to occur, while in 16-bit mode the entire counter must equal zero and decrement. The timer compare event will cause the timer status flag to set, the timer counter to load the contents of the timer compare register, the timer output to toggle, any configured transmit shift registers to load and any configured receive shift registers to store .

When the is Timer is configured to add a stop bit on each compare, the following additional events will occur.

1249

- Transmit shifters controlled by this timer will output their stop bit value (if configured by SSTOP).
- Receive shifters controlled by this timer will store the contents of the shift register in their shift buffer, as configured by SSTOP.
- On the first rising edge of the shifter clock after the compare, the timer counter will reload the current value of the Compare Register.

Transmit shifters must be configured to load on the first shift when the timer is configured to insert a stop bit on each compare.

When the condition configured by timer disable (TIMDIS) is detected, the following events occur.

- Timer counter will reload the current value of the Compare Register and start decrementing as configured by TIMDEC.
- Timer output will clear.
- Transmit shifters controlled by this timer will output their stop bit value (if configured by SSTOP).
- Receive shifters controlled by this timer will store the contents of the shift register in their shift buffer, as configured by SSTOP.

If the timer stop bit is enabled, the timer counter will continue decrementing until the next rising edge of the shift clock is detected, at which point it will finish. A timer enable condition can be detected in the same cycle as a timer disable condition (if timer stop bit is disabled), or on the first rising edge of the shift clock after the disable condition (if stop bit is enabled). Receive shift registers will stop bit enabled will store the contents of the shift register into the shift buffer and verify the state of the input data on the configured shift edge while the timer is in the stop state condition. If there is no configured edge between the timer disable and the next rising edge of the shift clock then the final store and verify do not occur.

47.4.3 Pin operation

The pin configuration for each timer and shifter can be configured to use any FlexIO pin with either polarity. Each timer and shifter can be configured as an input, output data, output enable or bidirectional output. A pin configured for output enable can be used as an open drain (with inverted polarity, since the output enable assertion would cause logic zero to be output on the pin) or to control the enable on the bidirectional output. Any timer or shifter could be configured to control the output enable for a pin where the bidirectional output data is driven by another timer or shifter.

Application Information

When configuring a pin as an input (this includes a timer trigger configured as a pin input), the input signal is first synchronized to the FlexIO clock before the signal is used by a timer or shifter. This introduces a small latency of between 0.5 to 1.5 FlexIO clock cycles when using an external pin input to generate an output or control a shifter. This sets the maximum setup time at 1.5 FlexIO clock cycles.

If an input is used by more than one timer or shifter then the synchronization occurs once to ensure any edge is seen on the same cycle by all timers and shifters using that input.

Note that FlexIO pins are also connected internally, configuring a FlexIO shifter or timer to output data on an unused pin will make an internal connection that allows other shifters and timer to use this pin as an input. This allows a shifter output to be used to trigger a timer or a timer output to be shifted into a shifter. This path is also synchronized to the FlexIO clock and therefore incurs a 1 cycle latency.

So when using a Pin input as a Timer Trigger, Timer Clock or Shifter Data Input, the following synchronization delays occur:

- 1. 0.5 1.5 FlexIO clock cycles for external pin
- 2. 1 FlexIO clock cycle for an internally driven pin

For timing considerations such as output valid time and input setup time for specific applications (SPI Master, SPI Slave, I2C Master, I2S Master, I2S Slave) please refer to the FlexIO Application Information Section.

47.5 Application Information

This section provides examples for a variety of FlexIO module applications.

47.5.1 UART Transmit

UART transmit can be supported using one Timer, one Shifter and one Pin (two Pins if supporting CTS). The start and stop bit insertion is handled automatically and multiple transfers can be supported using DMA controller. The timer status flag can be used to indicate when the stop bit of each word is transmitted.

Break and idle characters require software intervention, before transmitting a break or idle character the SSTART and SSTOP fields should be altered to transmit the required state and the data to transmit must equal 0xFF or 0x00. Supporting a second stop bit requires the stop bit to be inserted into the data stream using software (and increasing the

number of bits to transmit). Note that when performing byte writes to SHIFTBUFn (or SHIFTBUFBIS for transmitting MSB first), the rest of the register remains unaltered allowing an address mark bit or additional stop bit to remain undisturbed.

FlexIO does not support automatic insertion of parity bits.

Table 47-3. UART Transmit Configuration

Register	Value	Comments
SHIFTCFGn	0x0000_0032	Configure start bit of 0 and stop bit of 1.
SHIFTCTLn	0x0003_0002	Configure transmit using Timer 0 on posedge of clock with output data on Pin 0. Can invert output data by setting PINPOL, or can support open drain by setting PINPOL=0x1 and PINCFG=0x1.
TIMCMPn	0x0000_0F01	Configure 8-bit transfer with baud rate of divide by 4 of the FlexIO clock. Set TIMCMP[15:8] = (number of bits x 2) - 1. Set TIMCMP[7:0] = (baud rate divider / 2) - 1.
TIMCFGn	0x0000_2222	Configure start bit, stop bit, enable on trigger low and disable on compare. Can support CTS by configuring TIMEN=0x3.
TIMCTLn	0x01C0_0001	Configure dual 8-bit counter using Shifter 0 status flag as inverted internal trigger source. Can support CTS by configuring PINSEL=0x1 (for Pin 1) and PINPOL=0x1.
SHIFTBUFn	Data to transmit	Transmit data can be written to SHIFTBUF[7:0] to initiate an 8-bit transfer, use the Shifter Status Flag to indicate when data can be written using interrupt or DMA request. Can support MSB first transfer by writing to SHIFTBUFBBS[7:0] register instead.

47.5.2 UART Receive

UART receive can be supported using one Timer, one Shifter and one Pin (two Timers and two Pins if supporting RTS). The start and stop bit verification is handled automatically and multiple transfers can be supported using the DMA controller. The timer status flag can be used to indicate when the stop bit of each word is received.

Triple voting of the received data is not supported by FlexIO, data is sampled only once in the middle of each bit. Another timer can be used to implement a glitch filter on the incoming data, another Timer can also be used to detect an idle line of programmable length. Break characters will cause the error flag to set and the shifter buffer register will return 0x00.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Application Information

FlexIO does not support automatic verification of parity bits.

Table 47-4. UART Receiver Configuration

Register	Value	Comments
SHIFTCFGn	0x0000_0032	Configure start bit of 0 and stop bit of 1.
SHIFTCTLn	0x0080_0001	Configure receive using Timer 0 on negedge of clock with input data on Pin 0. Can invert input data by setting PINPOL.
TIMCMPn	0x0000_0F01	Configure 8-bit transfer with baud rate of divide by 4 of the FlexIO clock. Set TIMCMP[15:8] = (number of bits x 2) - 1. Set TIMCMP[7:0] = (baud rate divider / 2) - 1.
TIMCFGn	0x0204_2422	Configure start bit, stop bit, enable on pin posedge and disable on compare. Enable resynchronization to received data with TIMOUT=0x2 and TIMRST=0x4.
TIMCTLn	0x0000_0081	Configure dual 8-bit counter using inverted Pin 0 input.
SHIFTBUFn	Data to receive	Received data can be read from SHIFTBUFBYS[7:0], use the Shifter Status Flag to indicate when data can be read using interrupt or DMA request. Can support MSB first transfer by reading from SHIFTBUFBIS[7:0] register instead.

The UART Receiver with RTS configuration uses a 2nd Timer to generate the RTS output. The RTS will assert when the start bit is detected and negate when the data is read from the shifter buffer register. No start bit will be detected while the RTS is asserted, the received data is simply ignored.

Table 47-5. UART Receiver with RTS Configuration

Register	Value	Comments
SHIFTCFGn	0x0000_0032	Configure start bit of 0 and stop bit of 1.
SHIFTCTLn	0x0080_0001	Configure receive using Timer 0 on negedge of clock with input data on Pin 0. Can invert input data by setting PINPOL.
TIMCMPn	0x0000_0F01	Configure 8-bit transfer with baud rate of divide by 4 of the FlexIO clock. Set TIMCMP[15:8] = (number of bits x 2) - 1. Set TIMCMP[7:0] = (baud rate divider / 2) - 1.
TIMCFGn	0x0204_2522	Configure start bit, stop bit, enable on pin posedge with trigger low and disable on compare. Enable resynchronization

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

1253

Table 47-5. UART Receiver with RTS Configuration (continued)

Register	Value	Comments
		to received data with TIMOUT=0x2 and TIMRST=0x4.
TIMCTLn	0x03C0_0081	Configure dual 8-bit counter using inverted Pin 0 input. Trigger is internal using inverted Pin 1 input.
TIMCMP(n+1)	0x0000_FFFF	Never compare.
TIMCFG(n+1)	0x0030_6100	Enable on Timer N enable and disable on trigger falling edge. Decrement on trigger to ensure no compare.
TIMCTL(n+1)	0x0143_0083	Configure 16-bit counter and output on Pin 1. Trigger is internal using Shifter 0 flag.
SHIFTBUFn	Data to receive	Received data can be read from SHIFTBUFBYS[7:0], use the Shifter Status Flag to indicate when data can be read using interrupt or DMA request. Can support MSB first transfer by reading from SHIFTBUFBIS[7:0] register instead.

47.5.3 SPI Master

SPI master mode can be supported using two Timers, two Shifters and four Pins. Either CPHA=0 or CPHA=1 can be supported and transfers can be supported using the DMA controller. For CPHA=1, the select can remain asserted for multiple transfers and the timer status flag can be used to indicate the end of the transfer.

The stop bit is used to guarantee a minimum of 1 clock cycle between the slave select negating and before the next transfer. Writing to the transmit buffer by either core or DMA is used to initiate each transfer.

Due to synchronization delays, the setup time for the serial input data is 1.5 FlexIO clock cycles, so the maximum baud rate is divide by 4 of the FlexIO clock frequency.

Table 47-6. SPI Master (CPHA=0) Configuration

Register	Value	Comments
SHIFTCFGn	0x0000_0000	Start and stop bit disabled.
SHIFTCTLn	0x0083_0002	Configure transmit using Timer 0 on negedge of clock with output data on Pin 0.
SHIFTCFG(n+1)	0x0000_0000	Start and stop bit disabled.

Table continues on the next page...

Application Information

Table 47-6. SPI Master (CPHA=0) Configuration (continued)

Register	Value	Comments
SHIFTCTL(n+1)	0x0000_0101	Configure receive using Timer 0 on posedge of clock with input data on Pin 1.
TIMCMPn	0x0000_3F01	Configure 32-bit transfer with baud rate of divide by 4 of the FlexIO clock. Set TIMCMP[15:8] = (number of bits x 2) - 1. Set TIMCMP[7:0] = (baud rate divider / 2) - 1.
TIMCFGn	0x0100_2222	Configure start bit, stop bit, enable on trigger high and disable on compare, initial clock state is logic 0. Set PINPOL to invert the output shift clock.
TIMCTLn	0x01C3_0201	Configure dual 8-bit counter using Pin 2 output (shift clock), with Shifter 0 flag as the inverted trigger.
TIMCMP(n+1)	0x0000_FFFF	Never compare.
TIMCFG(n+1)	0x0000_1100	Enable when Timer 0 is enabled and disable when Timer 0 is disabled.
TIMCTL(n+1)	0x0003_0383	Configure 16-bit counter (never compare) using inverted Pin 3 output (as slave select).
SHIFTBUFn	Data to transmit	Transmit data can be written to SHIFTBUF, use the Shifter Status Flag to indicate when data can be written using interrupt or DMA request. Can support MSB first transfer by writing to SHIFTBUFBBS register instead.
SHIFTBUF(n+1)	Data to receive	Received data can be read from SHIFTBUFBYS, use the Shifter Status Flag to indicate when data can be read using interrupt or DMA request. Can support MSB first transfer by reading from SHIFTBUFBIS register instead.

Table 47-7. SPI Master (CPHA=1) Configuration

Register	Value	Comments
SHIFTCFGn	0x0000_0021	Start bit loads data on first shift.
SHIFTCTLn	0x0003_0002	Configure transmit using Timer 0 on posedge of clock with output data on Pin 0.
SHIFTCFG(n+1)	0x0000_0000	Start and stop bit disabled.
SHIFTCTL(n+1)	0x0080_0101	Configure receive using Timer 0 on negedge of clock with input data on Pin 1.
TIMCMPn	0x0000_3F01	Configure 32-bit transfer with baud rate of divide by 4 of the FlexIO clock. Set TIMCMP[15:8] = (number of bits x 2) - 1.

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Table 47-7. SPI Master (CPHA=1) Configuration (continued)

Register	Value	Comments
		Set TIMCMP[7:0] = (baud rate divider / 2) - 1.
TIMCFGn	0x0100_2222	Configure start bit, stop bit, enable on trigger high and disable on compare, initial clock state is logic 0. Set PINPOL to invert the output shift clock. Set TIMDIS=3 to keep slave select asserted for as long as there is data in the transmit buffer.
TIMCTLn	0x01C3_0201	Configure dual 8-bit counter using Pin 2 output (shift clock), with Shifter 0 flag as the inverted trigger.
TIMCMP(n+1)	0x0000_FFFF	Never compare.
TIMCFG(n+1)	0x0000_1100	Enable when Timer 0 is enabled and disable when Timer 0 is disabled.
TIMCTL(n+1)	0x0003_0383	Configure 16-bit counter (never compare) using inverted Pin 3 output (as slave select).
SHIFTBUFn	Data to transmit	Transmit data can be written to SHIFTBUF, use the Shifter Status Flag to indicate when data can be written using interrupt or DMA request. Can support MSB first transfer by writing to SHIFTBUFBBS register instead.
SHIFTBUF(n+1)	Data to receive	Received data can be read from SHIFTBUFBYS, use the Shifter Status Flag to indicate when data can be read using interrupt or DMA request. Can support MSB first transfer by reading from SHIFTBUFBIS register instead.

47.5.4 SPI Slave

SPI slave mode can be supported using one Timer, two Shifters and four Pins. Either CPHA=0 or CPHA=1 can be supported and transfers can be supported using the DMA controller. For CPHA=1, the select can remain asserted for multiple transfers and the timer status flag can be used to indicate the end of the transfer.

The transmit data must be written to the transmit buffer register before the external slave select asserts, otherwise the shifter error flag will be set.

Due to synchronization delays, the output valid time for the serial output data is 2.5 FlexIO clock cycles, so the maximum baud rate is divide by 6 of the FlexIO clock frequency.

Application Information

Table 47-8. SPI Slave (CPHA=0) Configuration

Register	Value	Comments
SHIFTCFGn	0x0000_0000	Start and stop bit disabled.
SHIFTCTLn	0x0083_0002	Configure transmit using Timer 0 on falling edge of shift clock with output data on Pin 0.
SHIFTCFG(n+1)	0x0000_0000	Start and stop bit disabled.
SHIFTCTL(n+1)	0x0000_0101	Configure receive using Timer 0 on rising edge of shift clock with input data on Pin 1.
TIMCMPn	0x0000_003F	Configure 32-bit transfer. Set TIMCMP[15:0] = (number of bits x 2) - 1.
TIMCFGn	0x0120_6000	Configure enable on trigger rising edge, initial clock state is logic 0 and decrement on pin input.
TIMCTLn	0x06C0_0203	Configure 16-bit counter using Pin 2 input (shift clock), with Pin 3 input (slave select) as the inverted trigger.
SHIFTBUFn	Data to transmit	Transmit data can be written to SHIFTBUF, use the Shifter Status Flag to indicate when data can be written using interrupt or DMA request. Can support MSB first transfer by writing to SHIFTBUFBBS register instead.
SHIFTBUF(n+1)	Data to receive	Received data can be read from SHIFTBUFBYS, use the Shifter Status Flag to indicate when data can be read using interrupt or DMA request. Can support MSB first transfer by reading from SHIFTBUFBIS register instead.

Table 47-9. SPI Slave (CPHA=1) Configuration

Register	Value	Comments
SHIFTCFGn	0x0000_0001	Shifter configured to load on first shift and stop bit disabled.
SHIFTCTLn	0x0003_0002	Configure transmit using Timer 0 on rising edge of shift clock with output data on Pin 0.
SHIFTCFG(n+1)	0x0000_0000	Start and stop bit disabled.
SHIFTCTL(n+1)	0x0080_0101	Configure receive using Timer 0 on falling edge of shift clock with input data on Pin 1.
TIMCMPn	0x0000_003F	Configure 32-bit transfer. Set TIMCMP[15:0] = (number of bits x 2) - 1.
TIMCFGn	0x0120_6602	Configure start bit, enable on trigger rising edge, disable on trigger falling edge, initial clock state is logic 0 and decrement on pin input.

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Table 47-9. SPI Slave (CPHA=1) Configuration (continued)

Register	Value	Comments
TIMCTLn	0x06C0_0203	Configure 16-bit counter using Pin 2 input (shift clock), with Pin 3 input (slave select) as the inverted trigger.
SHIFTBUFn	Data to transmit	Transmit data can be written to SHIFTBUF, use the Shifter Status Flag to indicate when data can be written using interrupt or DMA request. Can support MSB first transfer by writing to SHIFTBUFBBS register instead.
SHIFTBUF(n+1)	Data to receive	Received data can be read from SHIFTBUFBYS, use the Shifter Status Flag to indicate when data can be read using interrupt or DMA request. Can support MSB first transfer by reading from SHIFTBUFBIS register instead.

47.5.5 I2C Master

I2C master mode can be supported using two Timers, two Shifters and two Pins. One timer is used to generate the SCL output and one timer is used to control the shifters. The two shifters are used to transmit and receive for every word, when receiving the transmitter must transmit 0xFF to tristate the output. FlexIO inserts a stop bit after every word to generate/verify the ACK/NACK. FlexIO waits for the first write to the transmit data buffer before enabling SCL generation. Data transfers can be supported using the DMA controller and the shifter error flag will set on transmit underrun or receive overflow.

The first timer generates the bit clock for the entire packet (START to Repeated START/STOP), so the compare register needs to be programmed with the total number of clock edges in the packet (minus one). The timer supports clock stretching using the reset counter when pin equal to output (although this increases both the clock high and clock low periods by at least 1 FlexIO clock cycle each). The second timer uses the SCL input pin to control the transmit/receive shift registers, this enforces an SDA data hold time by an extra 2 FlexIO clock cycles.

Both the transmit and receive shifters need to be serviced for each word in the transfer, the transmit shifter must transmit 0xFF when receiving and the receive shifter returns the data actually present on the SDA pin. The transmit shifter will load 1 additional word on the last falling edge of SCL pin, this word should be 0x00 if generating a STOP condition or 0xFF if generating a repeated START condition. During the last word of a master-receiver transfer, the transmit SSTOP bit should be set by software to generate a NACK.

Application Information

The receive shift register will assert an error interrupt if a NACK is detected, but software is responsible for generating the STOP or repeated START condition. If a NACK is detected during master-transmit, the interrupt routine should immediately write the transmit shifter register with 0x00 (if generating STOP) or 0xFF (if generating repeated START). Software should then wait for the next rising edge on SCL and then disable both timers. The transmit shifter should then be disabled after waiting the setup delay for a repeated START or STOP condition.

Due to synchronization delays, the data valid time for the transmit output is 2 FlexIO clock cycles, so the maximum baud rate is divide by 6 of the FlexIO clock frequency.

The I2C master data valid is delayed 2 cycles because the clock output is passed through a synchronizer before clocking the transmit/receive shifter (to guarantee some SDA hold time). Since the SCL output is synchronous with FlexIO clock, the synchronization delay is 1 cycle and then 1 cycle to generate the output.

Table 47-10. I2C Master Configuration

Register	Value	Comments
SHIFTCFGn	0x0000_0032	Start bit enabled (logic 0) and stop bit enabled (logic 1).
SHIFTCTLn	0x0101_0082	Configure transmit using Timer 1 on rising edge of clock with inverted output enable (open drain output) on Pin 0.
SHIFTCFG(n+1)	0x0000_0020	Start bit disabled and stop bit enabled (logic 0) for ACK/NACK detection.
SHIFTCTL(n+1)	0x0180_0001	Configure receive using Timer 1 on falling edge of clock with input data on Pin 0.
TIMCMPn	0x0000_2501	Configure 2 word transfer with baud rate of divide by 4 of the FlexIO clock. Set TIMCMP[15:8] = (number of words x 18) + 1. Set TIMCMP[7:0] = (baud rate divider / 2) - 1.
TIMCFGn	0x0102_2222	Configure start bit, stop bit, enable on trigger high, disable on compare, reset if output equals pin. Initial clock state is logic 0 and is not affected by reset.
TIMCTLn	0x01C1_0101	Configure dual 8-bit counter using Pin 1 output enable (SCL open drain), with Shifter 0 flag as the inverted trigger.
TIMCMP(n+1)	0x0000_000F	Configure 8-bit transfer. Set TIMCMP[15:0] = (number of bits x 2) - 1.
TIMCFG(n+1)	0x0020_1112	Enable when Timer 0 is enabled, disable when Timer 0 is disabled, enable start bit and stop bit at end of each word, decrement on pin input.
TIMCTL(n+1)	0x01C0_0183	Configure 16-bit counter using inverted Pin 1 input (SCL).

Table continues on the next page...

Table 47-10. I2C Master Configuration (continued)

Register	Value	Comments
SHIFTBUFn	Data to transmit	Transmit data can be written to SHIFTBUFBBS[7:0], use the Shifter Status Flag to indicate when data can be written using interrupt or DMA request.
SHIFTBUF(n+1)	Data to receive	Received data can be read from SHIFTBUFBIS[7:0], use the Shifter Status Flag to indicate when data can be read using interrupt or DMA request.

47.5.6 I2S Master

I2S master mode can be supported using two Timers, two Shifters and four Pins. One timer is used to generate the bit clock and control the shifters and one timer is used to generate the frame sync. FlexIO waits for the first write to the transmit data buffer before enabling bit clock and frame sync generation. Data transfers can be supported using the DMA controller and the shifter error flag will set on transmit underrun or receive overflow.

The bit clock frequency is an even integer divide of the FlexIO clock frequency, and the initial frame sync assertion occurs at the same time as the first bit clock edge. The timer uses the start bit to ensure the frame sync is generated one clock cycle before the first output data.

Due to synchronization delays, the setup time for the receiver input is 1.5 FlexIO clock cycles, so the maximum baud rate is divide by 4 of the FlexIO clock frequency.

Table 47-11. I2S Master Configuration

Register	Value	Comments
SHIFTCFGn	0x0000_0001	Load transmit data on first shift and stop bit disabled.
SHIFTCTLn	0x0003_0002	Configure transmit using Timer 0 on rising edge of clock with output data on Pin 0.
SHIFTCFG(n+1)	0x0000_0000	Start and stop bit disabled.
SHIFTCTL(n+1)	0x0080_0101	Configure receive using Timer 0 on falling edge of clock with input data on Pin 1.
TIMCMPn	0x0000_3F01	Configure 32-bit transfer with baud rate of divide by 4 of the FlexIO clock. Set TIMCMP[15:8] = (number of bits x 2) - 1. Set TIMCMP[7:0] = (baud rate divider / 2) - 1.

Table continues on the next page...

Application Information

Table 47-11. I2S Master Configuration (continued)

Register	Value	Comments
TIMCFGn	0x0000_0202	Configure start bit, enable on trigger high and never disable. Initial clock state is logic 1.
TIMCTLn	0x01C3_0201	Configure dual 8-bit counter using Pin 2 output (bit clock), with Shifter 0 flag as the inverted trigger. Set PINPOL to invert the output shift clock.
TIMCMP(n+1)	0x0000_007F	Configure 32-bit transfer with baud rate of divide by 4 of the FlexIO clock. Set TIMCMP[15:0] = (number of bits x baud rate divider) - 1.
TIMCFG(n+1)	0x0000_0100	Enable when Timer 0 is enabled and never disable.
TIMCTL(n+1)	0x0003_0383	Configure 16-bit counter using inverted Pin 3 output (as frame sync).
SHIFTBUFn	Data to transmit	Transmit data can be written to SHIFTBUFBIS, use the Shifter Status Flag to indicate when data can be written using interrupt or DMA request. Can support LSB first transfer by writing to SHIFTBUF register instead.
SHIFTBUF(n+1)	Data to receive	Received data can be read from SHIFTBUFBIS, use the Shifter Status Flag to indicate when data can be read using interrupt or DMA request. Can support LSB first transfer by reading from SHIFTBUF register instead.

47.5.7 I2S Slave

I2S slave mode can be supported using two Timers, two Shifters and four Pins (for single transmit and single receive, other combinations of transmit and receive are possible).

The transmit data must be written to the transmit buffer register before the external frame sync asserts, otherwise the shifter error flag will be set.

Due to synchronization delays, the output valid time for the serial output data is 2.5 FlexIO clock cycles, so the maximum baud rate is divide by 6 of the FlexIO clock frequency.

The output valid time of I2S slave is max 2.5 cycles because there is a maximum 1.5 cycle delay on the clock synchronization plus 1 cycle to output the data

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018 1260 **NXP Semiconductors**

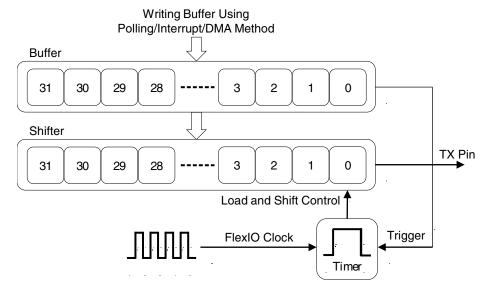
Table 47-12. I2S Slave Configuration

Register	Value	Comments
SHIFTCFGn	0x0000_0000	Start and stop bit disabled.
SHIFTCTLn	0x0103_0002	Configure transmit using Timer 1 on rising edge of shift clock with output data on Pin 0.
SHIFTCFG(n+1)	0x0000_0000	Start and stop bit disabled.
SHIFTCTL(n+1)	0x0180_0101	Configure receive using Timer 1 on falling edge of shift clock with input data on Pin 1.
TIMCMPn	0x0000_007D	Configure two 32-bit transfers per frame. Set TIMCMP[15:0] = (number of bits x 4) - 3.
TIMCFGn	0x0030_2400	Configure enable on pin rising edge (inverted frame sync) and disable on compare, initial clock state is logic 1 and decrement on trigger input (bit clock).
TIMCTLn	0x0440_0383	Configure 16-bit counter using inverted Pin 3 input (frame sync), with Pin 2 input (bit clock) as the trigger.
TIMCMP(n+1)	0x0000_003F	Configure 32-bit transfers. Set TIMCMP[15:0] = (number of bits x 2) - 1.
TIMCFG(n+1)	0x0020_3500	Configure enable on pin rising edge with trigger high and disable on compare with trigger low, initial clock state is logic 0 and decrement on pin input.
TIMCTL(n+1)	0x0340_0203	Configure 16-bit counter using Pin 2 input (bit clock), with Timer 0 output as the trigger.
SHIFTBUFn	Data to transmit	Transmit data can be written to SHIFTBUFBIS, use the Shifter Status Flag to indicate when data can be written using interrupt or DMA request. Can support LSB first transfer by writing to SHIFTBUF register instead.
SHIFTBUF(n+1)	Data to receive	Received data can be read from SHIFTBUFBIS, use the Shifter Status Flag to indicate when data can be read using interrupt or DMA request. Can support LSB first transfer by reading from SHIFTBUF register instead.

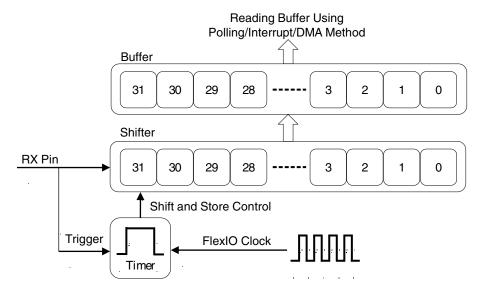
47.6 Usage Guide

UART Transmit

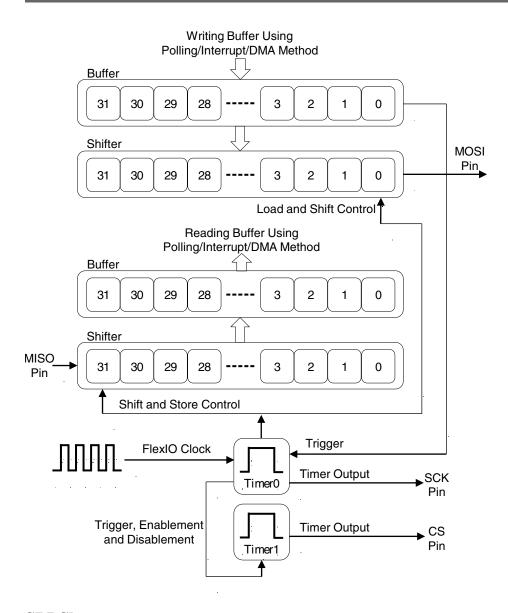
Usage Guide



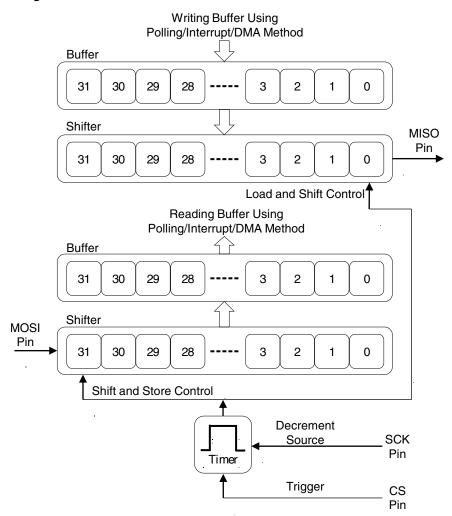
UART Receive



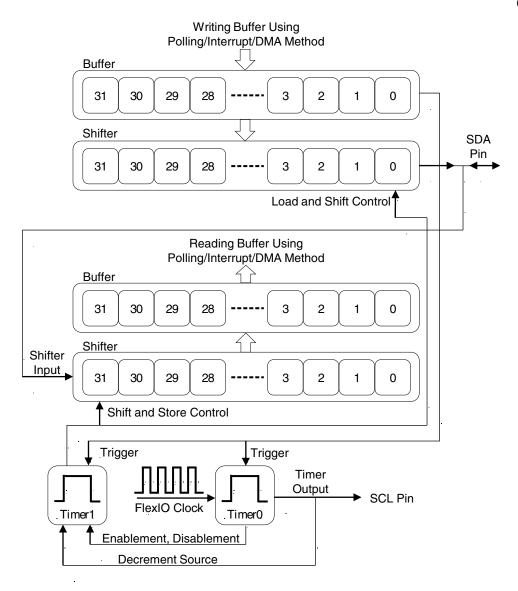
SPI Master



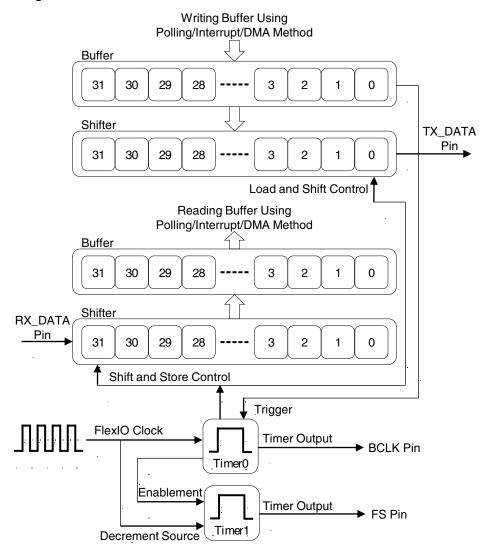
SPI Slave



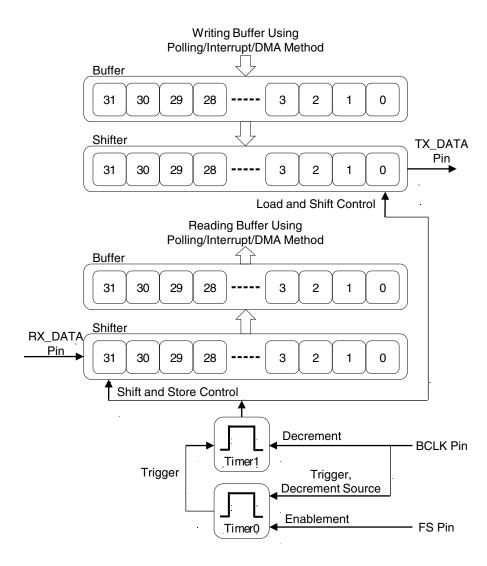
I2C Master



I2S Master



I2S Slave



Usage Guide

Chapter 48 Touch Sensing Input (TSI)

48.1 Chip-specific information for this module

48.1.1 Instantiation Information

Number of TSI module	1	
Number of input channels	up to 36 touch channels for mutual-cap mode	
	up to 25 touch channels for self-cap mode	
Support for low-power mode	one selectable pin is active	

48.1.1.1 TSI module functionality in MCU operation modes

In Stop, VLPS modes, only one TSI channel can be enabled to be the wakeup source. TS I hardware trigger is from the TRGMUX.

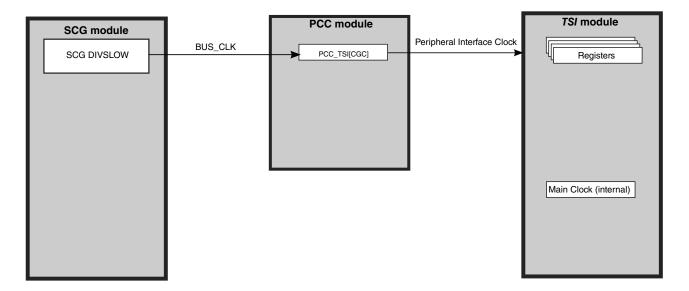
Table 48-1. TSI module functionality in MCU operation modes

MCU operation mode	TSI clock sources	TSI operation mode when GENCS[TSIEN] is 1	Functional electrode pins	Required GENCS[STPE] state
Run	BUS_CLK	Active mode	All	Don't care
Wait	BUS_CLK	Active mode	All	Don't care
Stop	Asynch operation	Stop mode	only 1	1
VLPR	BUS_CLK	Active mode	All	Don't care
VLPW	BUS_CLK	Active mode	All	Don't care
VLPS	Asynch operation	Stop mode	only 1	1

48.1.2 TSI Clocking Information

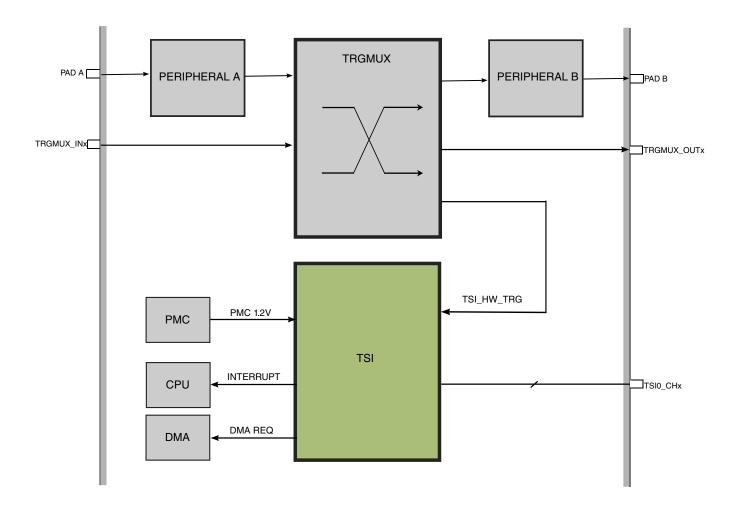
This following figure shows the TSI clocks.

Peripheral Clocking - TSI



48.1.3 Inter-connectivity Information

The TSI inter-connectivity is shown in the following diagram.



48.2 Introduction

Touch sensing interface (TSI) provides touch sensing detection on capacitive touch sensors. The external capacitive touch sensor is typically formed on PCB and the sensor electrodes are connected to TSI input channels through the I/O pins in the device.

The TSI operates in switching integration mode to achieve low-power, high-sensitivity and advanced EMC robustness. It supports both of self-cap and mutual-cap sensors. In self-cap mode, the TSI requires only one pin for each touch sensor. In mutual-cap mode, sensing is done using capacitive touch matrix in various Tx-Rx configurations. The TSI requires one pin per Tx line and one pin per Rx line.

It fully supports NXP touch sensing software (TSS) library which provides a solid capacitive measurement module to the implementation of touch keyboard, rotaries and sliders.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018 **NXP Semiconductors** 1271

48.2.1 **Features**

TSI features are as follows:

- Advanced EMC robustness
- Support both of Self-cap sensor and Mutual-cap sensor
- One pin per electrode no external components
- Adjustable touch sensing resolution and sensitivity for sensing a variety of overlay materials and thicknesses
- Low-power consumption
- Capability to wake up MCU from low power modes for low power application
- Support DMA data transfer
- Fully support NXP touch sensing software (TSS) library, see http://www.nxp.com/ touchsensing

For electrode design recommendations, refer to AN3863: Designing Touch Sensing Electrodes

Modes of operation 48.2.2

This module supports the following operation modes.

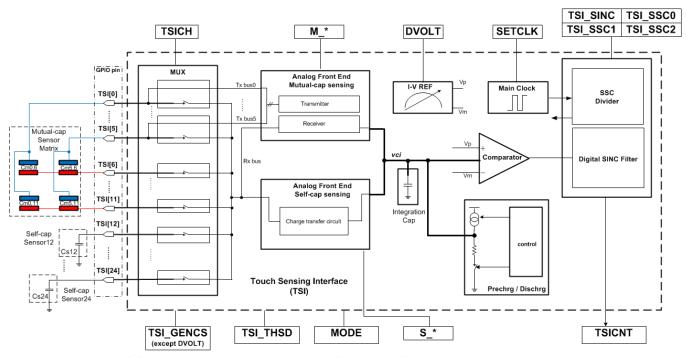
Mode Description Stop and low power stop TSI module is fully functional in all of the stop modes as long as TSI_GENCS[STPE] is set. The channel specified by TSI_DATA[TSICH] will be scanned upon the trigger. After scan finishes, either end-of-scan or out-of-range interrupt can be selected to bring MCU out of low power modes. Wait TSI module is fully functional in this mode. When a scan completes, TSI submits an interrupt request to CPU if the interrupt is enabled. TSI module is fully functional in this mode. When a scan Run completes, TSI submits an interrupt request to CPU if the interrupt is enabled.

Table 48-2. Operating modes

Block diagram 48.2.3

The following figure is a block diagram of the TSI module.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018 1272 NXP Semiconductors



S_* stands for all registers whose name starts from S_. It controls self-cap sensing.

M_* stands for all registers whose name starts from M_. It controls mutual-cap sensing.

Figure 48-1. TSI module block diagram

48.3 External signal description

The TSI module contains up to 25 external pins for touch sensing. The table found here describes each of the TSI external pins.

Table 48-3. TSI signal description (self-cap sensing)

Name	Port	Direction	Function	Reset state
TSI[24:0]	TSI	I/O	TSI sensing pins or GPIO pins.	I/O

Table 48-4. TSI signal description (mutual-cap sensing)

Name	Port	Direction	Function	Reset state
TSI[5:0]	TSI	I/O	TSI Tx pins or GPIO pins.	I/O
TSI[11:6]	TSI	I/O	TSI Rx pins or GPIO pins.	I/O
TSI[24:12]	TSI	I/O	GPIO pins.	I/O

NOTE

If TSI mutual mode is enabled, all 6 Tx channels/pins are supposed to be used for TSI functions, and any unused Tx channel (e.g. PTD1/Channel5) cannot be used for other functions (such as GPIO). For example, if 4 Tx pins are used for mutual touch keys, the other 2 unused Tx pins cannot be used for GPIO or other functions. The root cause is: when scanning one Tx channel, the TSI module pulls down all other Tx channels (which are not in scan). All Rx channels do not have such limitation, as Rx channels keep Hi-Z during scanning.

48.3.1 TSI[24:0]

When TSI functionality is enabled, the TSI analog portion uses the corresponding channel to connect external on-board touch capacitors. The PCB connection between the pin and the touch pad must be kept as short as possible to reduce parasitic capacity on board.

48.4 Register definition

This section describes the memory map and control/status registers for the TSI module.

TSI memory map

Absolute address (hex)	Register name		Access	Reset value	Section/ page
4004_5000	TSI General Control and Status Register (TSI_GENCS)	32	R/W	0000_0000h	48.4.1/1275
4004_5004	TSI DATA Register (TSI_DATA)	32	R/W	0000_0000h	48.4.2/1278
4004_5008	TSI Threshold Register (TSI_TSHD)	32	R/W	0000_0000h	48.4.3/1279
4004_500C	TSI MODE Register (TSI_MODE)	32	R/W	003C_0060h	48.4.4/1280
4004_5010	TSI MUTUAL-CAP Register 0 (TSI_MUL0)	32	R/W	603F_6300h	48.4.5/1282
4004_5014	TSI MUTUAL-CAP Register 1 (TSI_MUL1)	32	R/W	0005_007Eh	48.4.6/1285
4004_5018	TSI SINC filter Register (TSI_SINC)	32	R/W	0007_0001h	48.4.7/1288
4004_501C	TSI SSC Register 0 (TSI_SSC0)	32	R/W	6032_0000h	48.4.8/1292
4004_5020	TSI SSC Register 0 (TSI_SSC1)	32	R/W	0060_0040h	48.4.9/1294
4004_5024	TSI SSC Register 2 (TSI_SSC2)	32	R/W	1008_0101h	48.4.10/ 1295

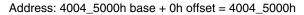
1275

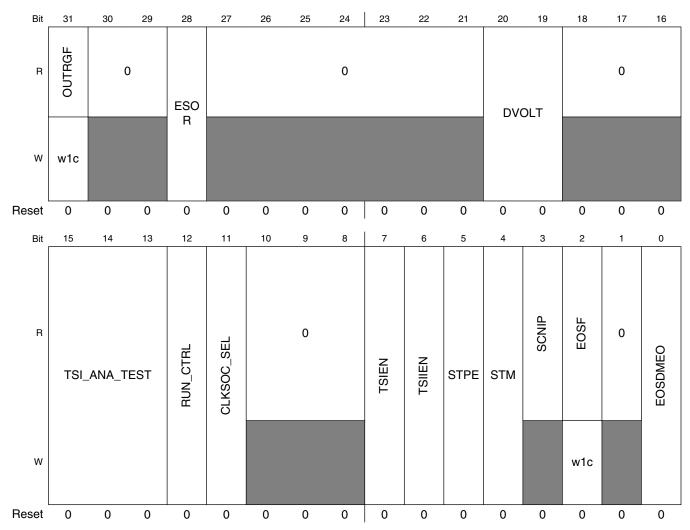
48.4.1 TSI General Control and Status Register (TSI_GENCS)

This control register provides various control and configuration information for the TSI module.

NOTE

When TSI is working, the configuration bits (GENCS[TSIEN], GENCS[TSIIEN], and GENCS[STM]) must not be changed. The EOSF flag is kept until the software acknowledge it.





TSI_GENCS field descriptions

	Field	Description
Ī	31	Out of Range Flag.
	OUTRGF	

Table continues on the next page...

Register definition

TSI_GENCS field descriptions (continued)

Field	Description
	This flag is set if the result register of the enabled electrode is out of the range defined by the TSI_THRESHOLD register. It can be read once the CPU wakes. Write "1", when this flag is set, to clear it.
30–29 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
28 ESOR	End-of-scan or Out-of-Range Interrupt Selection This bit is used to select out-of-range or end-of-scan event to generate an interrupt. Out-of-range interrupt is allowed. End-of-scan interrupt is allowed.
27–21 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
20–19 DVOLT	DVOLT select comparator Vm, Vp. From DIP. 00 Vm=0.3V; Vp=1.3V; dvolt=1.0V. 01 Vm=0.3V; Vp=1.6V; dvolt=1.3V. 10 Vm=0.3V; Vp=1.9V; dvolt=1.6V. 11 Vm=0.3V; Vp=2.3V; dvolt=2.0V.
18–16 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
15–13 TSI_ANA_TEST	TSI_ANA_TEST These bits can only be accessed when in test mode .
12 RUN_CTRL	RUN_CTRL This bit can only be accessed when in test mode .
11 CLKSOC_SEL	CLKSOC_SEL This bit can only be accessed when in test mode .
10–8 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
7 TSIEN	Touch Sensing Input Module Enable This bit enables TSI module. 0 TSI module disabled. 1 TSI module enabled.
6 TSIIEN	Touch Sensing Input Interrupt Enable This bit enables TSI module interrupt request to CPU when the scan completes. The interrupt will wake MCU from low power mode if this interrupt is enabled. 0 TSI interrupt is disabled. 1 TSI interrupt is enabled.
5 STPE	TSI STOP Enable This bit enables TSI module function in low power modes (stop, VLPS).

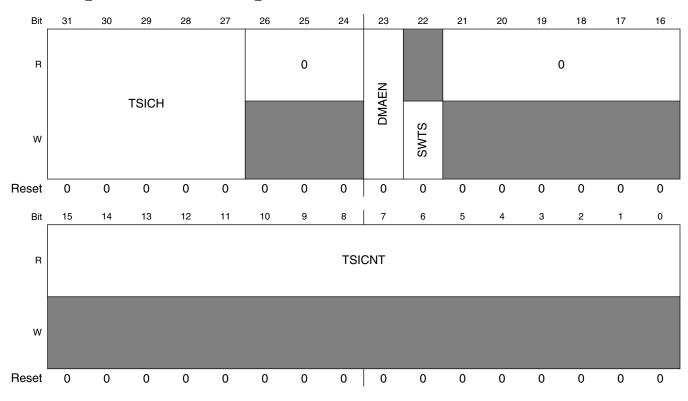
Table continues on the next page...

TSI_GENCS field descriptions (continued)

Field	Description
	0 TSI is disabled when MCU goes into low power mode.
	1 Allows TSI to continue running in all low power modes.
4 STM	Scan Trigger Mode
	This bit specifies the trigger mode. User is allowed to change this bit when TSI is not working in progress.
	0 Software trigger scan.
	1 Hardware trigger scan.
3 SCNIP	Scan In Progress Status
	This read-only bit indicates if scan is in progress. This bit will get asserted after the analog bias circuit is stable after a trigger and it changes automatically by the TSI.
	0 No scan in progress.
1 Scan in progress.	
2 EOSF	End of Scan Flag
	This flag is set when all active electrodes are finished scanning after a scan trigger. Write "1", when this flag is set, to clear it.
	0 Scan not complete.
	1 Scan complete.
1	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
0 EOSDMEO	End-of-Scan DMA Transfer Request Enable Only
EOSDIVIEO	This bit makes simultaneous DMA request at End-of-Scan and Interrupt at Out-of-Range possible.
	EOSDMEO has precedence to ESOR when trying to set this bit and ESOR bit. When EOSDMEO = 1,
	End-of-Scan will generate DMA request and Out-of-Range will generate interrupt.
	0 Do not enable the End-of-Scan DMA transfer request only. Depending on ESOR state, either Out-of-Range or End-of-Scan can trigger a DMA transfer request and interrupt.
	Only the End-of-Scan event can trigger a DMA transfer request. The Out-of-Range event only and always triggers an interrupt if TSIIE is set.

48.4.2 TSI DATA Register (TSI_DATA)

Address: 4004_5000h base + 4h offset = 4004_5004h



TSI_DATA field descriptions

Field		Description			
31–27 TSICH	TSICH	TSICH			
	(TSI_G	e bits specify current channel to be measured for self-cap mode. In hardware trigger mode _GENCS[STM] = 1), the scan will not start until the hardware trigger occurs. In software trigger mode _GENCS[STM] = 0), the scan starts immediately when TSI_DATA[SWTS] bit is written by 1.			
	00000	For self-cap mode: Channel 0.			
	00001	For self-cap mode: Channel 1.			
	00010	For self-cap mode: Channel 2.			
	00011	For self-cap mode: Channel 3.			
	00100	For self-cap mode: Channel 4.			
	00101	For self-cap mode: Channel 5.			
	00110	For self-cap mode: Channel 6.			
	00111	For self-cap mode: Channel 7.			
	01000	For self-cap mode: Channel 8.			
	01001	For self-cap mode: Channel 9.			
	01010	For self-cap mode: Channel 10.			
	01011	For self-cap mode: Channel 11.			
	01100	For self-cap mode: Channel 12.			
	01101	For self-cap mode: Channel 13.			
	01110	For self-cap mode: Channel 14.			

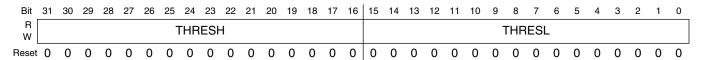
Table continues on the next page...

TSI_DATA field descriptions (continued)

Field	Description			
	01111 For self-cap mode: Channel 15.			
	10000 For self-cap mode: Channel 16.			
	10001 For self-cap mode: Channel 17.			
	10010 For self-cap mode: Channel 18.			
	10011 For self-cap mode: Channel 19.			
	10100 For self-cap mode: Channel 20.			
	10101 For self-cap mode: Channel 21.			
	10110 For self-cap mode: Channel 22.			
	10111 For self-cap mode: Channel 23.			
	11000 For self-cap mode: Channel 24.			
26–24	This field is reserved.			
Reserved	This read-only field is reserved and always has the value 0.			
23	DMA Transfer Enabled			
DMAEN	This bit is used together with the TSI interrupt enable bits(TSIIE, ESOR) to generate a DMA transfer			
	request instead of an interrupt.			
	0 Interrupt is selected when the interrupt enable bit is set and the corresponding TSI events assert.			
	1 DMA transfer request is selected when the interrupt enable bit is set and the corresponding TSI events assert.			
22	Software Trigger Start			
SWTS	This write only hit is a postavana stant triangur VA/hara CTNA hit is along write 11411 to this hit will stant a coop			
	This write-only bit is a software start trigger. When STM bit is clear, write "1" to this bit will start a scan. The electrode channel to be scanned is determined by TSI_DATA[TSICH] bits			
	The distinct to be occurred to determined by Tel_D/T/\{Teleff\} bito			
	0 No effect.			
	1 Start a scan to determine which channel is specified by TSI_DATA[TSICH].			
21–16	This field is reserved.			
Reserved	This read-only field is reserved and always has the value 0.			
TSICNT	TSI Conversion Counter Value			
	These read-only bits record the accumulated scan counter value ticked by the reference oscillator.			

48.4.3 TSI Threshold Register (TSI_TSHD)

Address: 4004_5000h base + 8h offset = 4004_5008h



TSI_TSHD field descriptions

Field	Description
31–16 THRESH	TSI Wakeup Channel High-threshold
	This half-word specifies the high threshold of the wakeup channel.

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

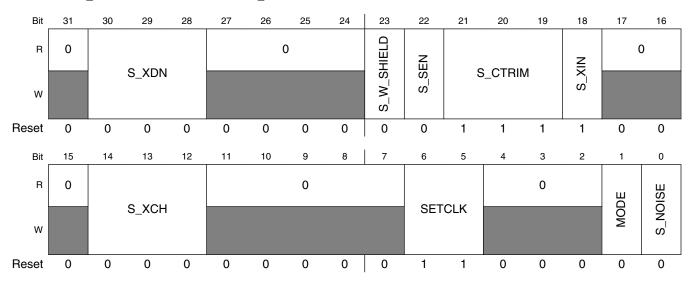
Register definition

TSI_TSHD field descriptions (continued)

Field	Description
THRESL	TSI Wakeup Channel Low-threshold
	This half-word specifies the low threshold of the wakeup channel.

48.4.4 TSI MODE Register (TSI_MODE)

Address: 4004_5000h base + Ch offset = 4004_500Ch



TSI_MODE field descriptions

Field	Description
31	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
30–28 S_XDN	S_XDN
	When TSI_MODE[S_SEN]=1, adjust sensitivity.
	000 1/16.
	001 1/8.
	010 1/4.
	011 1/2.
	100 NA.
	101 NA.
	110 NA.
	111 NA.
27–24	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
23	S_W_SHIELD
S_W_SHIELD	Shield switch control when TSI_MODE[MODE] = '0'.

Table continues on the next page...

TSI_MODE field descriptions (continued)

Field	Description
	0 shield switch off.
	1 shield switch on.
22	S_SEN
S_SEN	Sensitivity boost mode of self-cap.
	0 Sensitivity boost off.
01.10	1 Sensitivity boost on.
21-19 S_CTRIM	Capacitor trim setting When TSI_MODE[S_SEN]=1, adjust sensitivity.
	WHEN TOI_MODE[O_OEN]=1, adjust sensitivity.
	000 Ctrim=2.5p.
	001 Ctrim=5.0p.
	010 Ctrim=7.5p.
	011 Ctrim=10p.
	100 Ctrim=12.5p. 101 Ctrim=15p.
	110 Ctrim=17.5p.
	111 Ctrim=20p.
18	S_XIN
S_XIN	Input current multiple.
	0 1/8.
	1 1/4.
17–15	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
14–12 S_XCH	S_XCH
_	Charge/Discharge current multiple.
	000 1/16.
	001 1/8.
	010 1/4.
	011 1/2.
	100 NA.
	101 NA. 110 NA.
	110 NA.
11–7	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
6–5 SETCLK	SETCLK
	Set main clock frequency.
	00 20.72MHz.
	01 16.65MHz.
	10 13.87MHz.
	11 11.91MHz.

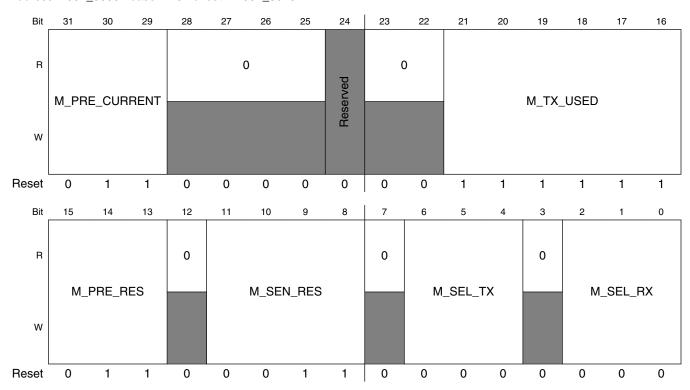
Table continues on the next page...

TSI_MODE field descriptions (continued)

Field	Description
4–2 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
1 MODE	MODE Select sensing mod. 0 self-cap mode. 1 mutual-cap mode.
0 S_NOISE	S_NOISE Noise cancellation mode of self-cap. 0 noise cancellation off. 1 noise cancellation on.

48.4.5 TSI MUTUAL-CAP Register 0 (TSI_MUL0)

Address: 4004_5000h base + 10h offset = 4004_5010h



TSI_MUL0 field descriptions

Field	Description
	M_PRE_CURRENT
M_PRE_ CURRENT	Choose the current used in Vref generator, default 4uA.

Table continues on the next page...

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

TSI_MUL0 field descriptions (continued)

Field	Description
	000 1uA.
	001 2uA.
	010 3uA.
	011 4uA.
	100 5uA.
	101 6uA.
	110 7uA. 111 8uA.
28–25	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
24	This field is reserved.
Reserved	
23–22	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
21–16	M_TX_USED
M_TX_USED	Indicates which channel used for mutual cap TX.
	Value 1 means used for mutual cap; value 0 means used for GPIO.
15–13	M_PRE_RES
M_PRE_RES	
	choose the resistor used in pre-charge, default 4k.
	000 1k.
	001 2k.
	010 3k.
	011 4k.
	100 5k.
	101 6k. 110 7k.
	111 8k.
12	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
11–8	M_SEN_RES
M_SEN_RES	
	Choose the resistor used in the I_sense generator, default 10k.
	0000 2.5k.
	0001 5k.
	0010 7.5k.
	0011 10k.
	0100 12.5k. 0101 15k.
	0101 15k. 0110 17.5k.
	0111 20k.
	1000 22.5k.
	1001 25k.
	1010 27.5k.
	1011 30k.

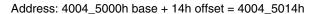
Table continues on the next page...

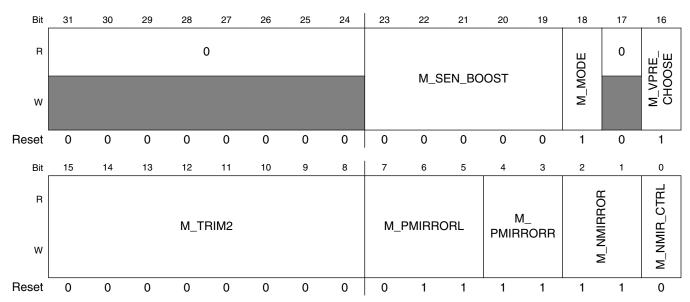
Register definition

TSI_MUL0 field descriptions (continued)

Field	Description
	1100 32.5k.
	1101 35k.
	1110 37.5k.
	1111 40k.
7	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
6–4	M_SEL_TX
M_SEL_TX	TX channel selection when TSI_MODE[MODE] = '1'.
	TX Charliner selection when TSI_MODE[MODE] = 1.
	000 select channel 0 as tx0.
	001 select channel 1 as tx1.
	010 select channel 2 as tx2.
	011 select channel 3 as tx3.
	100 select channel 4 as tx4.
	101 select channel 5 as tx5.
	110 NA.
	111 NA.
3	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
M_SEL_RX	M_SEL_RX
	RX channel selection when TSI_MODE[MODE] = '1'.
	000 select channel 6 as rx6.
	001 select channel 7 as rx7.
	010 select channel 8 as rx8.
	011 select channel 9 as rx9.
	100 select channel 10 as rx10.
	101 select channel 11 as rx11.
	110 NA.
	111 NA.

48.4.6 TSI MUTUAL-CAP Register 1 (TSI_MUL1)





TSI_MUL1 field descriptions

Field	Description
31–24	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
23–19	M_SEN_BOOST
M_SEN_BOOST	
	Choose the sensitivity boost current, default 0.
	00000 Ou.
	00001 2u.
	00010 4u.
	00011 6u.
	00100 8u.
	00101 10u.
	00110 12u.
	00111 14u
	01000 16u.
	01001 18u.
	01010 20u.
	01011 22u.
	01100 24u.
	01101 26u.
	01110 28u.
	01111 30u.
	10000 32u.
	10001 34u.
1	10010 36u.

Table continues on the next page...

TSI_MUL1 field descriptions (continued)

Field	Description
	10011 38u.
	10100 40u.
	10101 42u.
	10110 44u.
	10111 46u.
	11000 48u.
	11001 50u.
	11010 52u.
	11011 54u.
	11100 56u.
	11101 58u.
	11110 60u. 11111 62u.
10	
18 M_MODE	M_MODE
M_WODE	TX drive mode control, default 0V~5V.
	0 577 577
	0 -5V~+5V. 1 0V~+5V.
47	
17 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
16	M_VPRE_CHOOSE
M_VPRE_	W_V1 112_0110002
CHOOSE	Digital control signal for pre-voltage choose.
	0 Internal 1.2V voltage.
	1 1.2V PMC output.
15–8	M_TRIM2
M_TRIM2	M_TRIM2[7:0] is for trim use.
	For M_TRIM2[0],
	 value 0: choose Vref as source of Vp/Vm/Vmid; value 1: choose Vpre in mutual AFE as source of Vp/Vm/Vmid. When this bit is set to 1, it will
	choose Vp/Vm/Vmid from a resistor divider from VDD5V to ground. Then it could help reduce
	variation on the power VDD5V.
	For M. TDIMO(6)
	For M_TRIM2[6], • value 0: choose Vp-0.1V as Vmid;
	• value 1: choose Vp-0.4V as Vmid.
7–5	M_PMIRRORL
M_PMIRRORL	DMOC assument resignant and the sleft side, defeated as 10
	PMOS current mirror on the left side, default m=16.
	000 m=4.
	001 m=8.
	010 m=12.
	011 m=16.
	100 m=20.
	101 m=24.
	110 m=28.
	111 m=32.

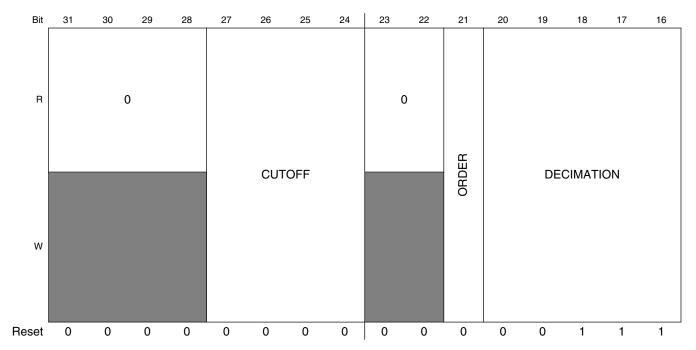
Table continues on the next page...

TSI_MUL1 field descriptions (continued)

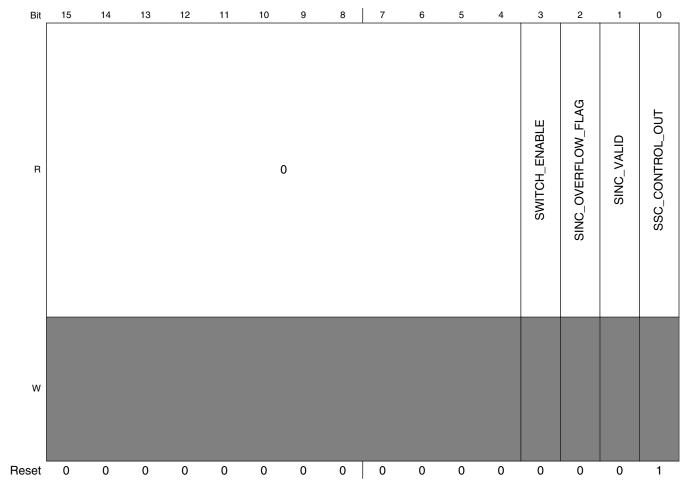
Field	Description
4–3	M_PMIRRORR
M_PMIRRORR	PMOS current mirror on the right side, default m=4.
	00 m=1.
	01 m=2.
	10 m=3.
	11 m=4.
2–1	M_NMIRROR
M_NMIRROR	NMOS current mirror, default m=4.
	00 m=1.
	01 m=2.
	10 m=3.
	11 m=4.
0	M_NMIR_CTRL
M_NMIR_CTRL	NMOS mirror control signal, default enable.
	0 Enable NMOS mirror.
	1 Disable NMOS mirror.

TSI SINC filter Register (TSI_SINC)

Address: 4004_5000h base + 18h offset = 4004_5018h



Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018 1288 **NXP Semiconductors**



TSI_SINC field descriptions

Field	Description
31–28	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
27–24 CUTOFF	CUTOFF
	The value of shifting out lower bits of counter, equal to divide the result by div, default div=0.
	0000 div=1.
	0001 div=2.
	0010 div=4.
	0011 div=8.
	0100 div=16.
	0101 div=32.
	0110 div=64.
	0111 div=128.
	1000 NC.
	1001 NC.
	1010 NC.
	1011 NC.
	1100 NC.

Table continues on the next page...

Register definition

TSI_SINC field descriptions (continued)

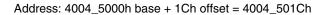
Field	Description
	1101 NC
	1110 NC.
	1111 NC.
23–22	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
21	ORDER
ORDER	
	Select the order of SINC filter, the SINC filter is a digital decimation filter for filtering out the low frequency noise from EMC (Electro Magnetic Compatibility).
	0 Using 1 order SINC filter.
	1 Using 2 order SINC filter.
20–16	DECIMATION
DECIMATION	
	Choose the decimation value of the SINC filter.
	00000 The TSI_DATA[TSICNT] bits is the counter value of 1 scan period.
	00001 The TSI_DATA[TSICNT] bits is the counter value of 2 scan periods.
	00010 The TSI_DATA[TSICNT] bits is the counter value of 3 scan periods.
	00011 The TSI_DATA[TSICNT] bits is the counter value of 4 scan periods.
	00100 The TSI_DATA[TSICNT] bits is the counter value of 5 scan periods.
	00101 The TSI_DATA[TSICNT] bits is the counter value of 6 scan periods.
	00110 The TSI_DATA[TSICNT] bits is the counter value of 7 scan periods.
	00111 The TSI_DATA[TSICNT] bits is the counter value of 8 scan periods.
	01000 The TSI_DATA[TSICNT] bits is the counter value of 9 scan periods.
	01001 The TSI_DATA[TSICNT] bits is the counter value of 10 scan periods.
	01010 The TSI_DATA[TSICNT] bits is the counter value of 11 scan periods.
	01011 The TSI_DATA[TSICNT] bits is the counter value of 12 scan periods.
	01100 The TSI_DATA[TSICNT] bits is the counter value of 13 scan periods.
	01101 The TSI_DATA[TSICNT] bits is the counter value of 14 scan periods.
	01110 The TSI_DATA[TSICNT] bits is the counter value of 15 scan periods.
	01111 The TSI_DATA[TSICNT] bits is the counter value of 16 scan periods. 10000 The TSI_DATA[TSICNT] bits is the counter value of 17 scan periods.
	10000 The TSI_DATA[TSICNT] bits is the counter value of 17 scan periods.
	10010 The TSI_DATA[TSICNT] bits is the counter value of 19 scan periods.
	10011 The TSI_DATA[TSICNT] bits is the counter value of 20 scan periods.
	10100 The TSI_DATA[TSICNT] bits is the counter value of 21 scan periods.
	10101 The TSI_DATA[TSICNT] bits is the counter value of 22 scan periods.
	10110 The TSI_DATA[TSICNT] bits is the counter value of 23 scan periods.
	10111 The TSI_DATA[TSICNT] bits is the counter value of 24 scan periods.
	11000 The TSI_DATA[TSICNT] bits is the counter value of 25 scan periods.
	11001 The TSI_DATA[TSICNT] bits is the counter value of 26 scan periods.
	11010 The TSI_DATA[TSICNT] bits is the counter value of 27 scan periods.
	11011 The TSI_DATA[TSICNT] bits is the counter value of 28 scan periods.
	11100 The TSI_DATA[TSICNT] bits is the counter value of 29 scan periods.
	11101 The TSI_DATA[TSICNT] bits is the counter value of 30 scan periods.
	11110 The TSI_DATA[TSICNT] bits is the counter value of 31 scan periods.
	11111 The TSI_DATA[TSICNT] bits is the counter value of 32 scan periods.

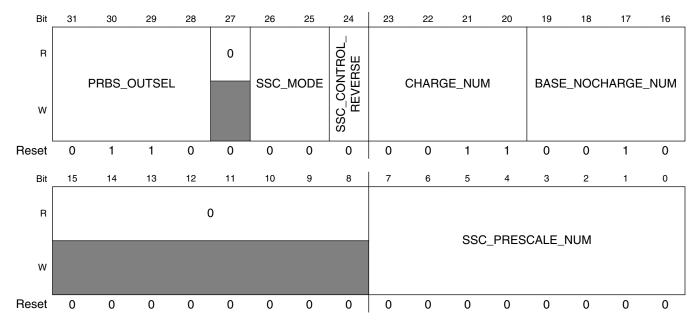
Table continues on the next page...

TSI_SINC field descriptions (continued)

Field	Description
15–4	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
3 SWITCH_ ENABLE	SWITCH_ENABLE Indicating the state of SSC (spread spectrum clocking), for digital testing. SSC function is used for
	spreading frequency of sampling clock, reducing EMC (Electro Magnetic Compatibility).
	0 SSC function is disabled.
	1 SSC function is enabled.
2 SINC_	SINC_OVERFLOW_FLAG
OVERFLOW_ FLAG	Indicating whether the counter result in TSI_DATA[TSICNT] has an overflow occurrence in the last scan process. Note: this bit has no default value, please force it to 0 or deposit it if necessary.
	0 The counter result has no overflow occurrence in the last scan process.
	1 The counter result has an overflow occurrence in the last scan process.
1	SINC_VALID
SINC_VALID	Indicating the state of SINC filter, for digital testing.
	0 SINC filter is disabled.
	1 SINC filter is enabled.
0	SSC_CONTROL_OUT
SSC_ CONTROL_OUT	Indicating the state of SSC output value, for digital testing.
	0 SSC output value is 0.
	1 SSC output value is 1.

48.4.8 TSI SSC Register 0 (TSI_SSC0)





TSI_SSC0 field descriptions

Field	Description
31–28	PRBS_OUTSEL
PRBS_OUTSEL	When SSC0[SSC_MODE] = 2"h00, cheeping the length of the BBBS (Beaude BendemBinery/Seguence)
	When SSC0[SSC_MODE] = 2'b00, choosing the length of the PRBS (Pseudo-RandomBinarySequence) method.
	0000 NC.
	0001 NC.
	0010 The length of the PRBS is 2.
	0011 The length of the PRBS is 3.
	0100 The length of the PRBS is 4.
	0101 The length of the PRBS is 5.
	0110 The length of the PRBS is 6.
	0111 The length of the PRBS is 7.
	1000 The length of the PRBS is 8.
	1001 The length of the PRBS is 9.
	1010 The length of the PRBS is 10.
	1011 The length of the PRBS is 11.
	1100 The length of the PRBS is 12.
	1101 The length of the PRBS is 13.
	1110 The length of the PRBS is 14.
	1111 The length of the PRBS is 15.
27	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.

Table continues on the next page...

TSI_SSC0 field descriptions (continued)

Field	Description
26–25	SSC_MODE
SSC_MODE	
	Choosing the SSC mode.
	00 Using PRBS method generating SSC output bit.
	01 Using up-down counter generating SSC output bit.
	10 SSC function is disabled.
	11 NC.
24	SSC_CONTROL_REVERSE
SSC_	
CONTROL_	Reversing the SSC output bit's polarity or not.
REVERSE	0 Keep the polarity of the SSC output bit.
	1 Reverse the polarity of the SSC output bit.
23–20	CHARGE_NUM
CHARGE_NUM	
	Choosing the period of the SSC output bit 0's period, when using up-down counter mode.
	0000 The SSC output bit 0's period will be 1 clock cycle of system clock.
	0001 The SSC output bit 0's period will be 2 clock cycles of system clock.
	0010 The SSC output bit 0's period will be 3 clock cycles of system clock.
	0011 The SSC output bit 0's period will be 4 clock cycles of system clock.
	0100 The SSC output bit 0's period will be 5 clock cycles of system clock.
	0101 The SSC output bit 0's period will be 6 clock cycles of system clock.
	0110 The SSC output bit 0's period will be 7 clock cycles of system clock.
	0111 The SSC output bit 0's period will be 8 clock cycles of system clock.
	1000 The SSC output bit 0's period will be 9 clock cycles of system clock.
	1001 The SSC output bit 0's period will be 10 clock cycles of system clock.
	1010 The SSC output bit 0's period will be 11 clock cycles of system clock.
	1011 The SSC output bit 0's period will be 12 clock cycles of system clock.
	1100 The SSC output bit 0's period will be 13 clock cycles of system clock.
	1101 The SSC output bit 0's period will be 14 clock cycles of system clock.
	1110 The SSC output bit 0's period will be 15 clock cycles of system clock.
	1111 The SSC output bit 0's period will be 16 clock cycles of system clock.
19–16 BASE_	BASE_NOCHARGE_NUM
NOCHARGE_	Choosing the basic period of the SSC output bit 1's period, when using up-down counter mode. Together
NUM	with the TSI_SSC2[MOVE_ NOCHARGE_MAX] and TSI_SSC2[MOVE_ NOCHARGE_MIN], they are
	determining the SSC output 1's period.
	0000 The SSC output bit 1's basic period will be 1 clock cycle of system clock.
	0001 The SSC output bit 1's basic period will be 2 clock cycles of system clock.
	0010 The SSC output bit 1's basic period will be 3 clock cycles of system clock.
	0011 The SSC output bit 1's basic period will be 4 clock cycles of system clock.
	0100 The SSC output bit 1's basic period will be 5 clock cycles of system clock.
	0101 The SSC output bit 1's basic period will be 6 clock cycles of system clock.
	0110 The SSC output bit 1's basic period will be 7 clock cycles of system clock.
	0111 The SSC output bit 1's basic period will be 8 clock cycles of system clock.
	1000 The SSC output bit 1's basic period will be 9 clock cycles of system clock.
	1001 The SSC output bit 1's basic period will be 10 clock cycles of system clock.

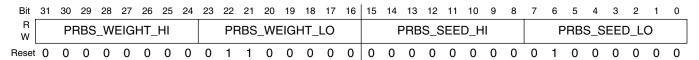
Table continues on the next page...

TSI_SSC0 field descriptions (continued)

Field	Description
	1010 The SSC output bit 1's basic period will be 11 clock cycles of system clock.
	1011 The SSC output bit 1's basic period will be 12 clock cycles of system clock.
	1100 The SSC output bit 1's basic period will be 13 clock cycles of system clock.
	1101 The SSC output bit 1's basic period will be 14 clock cycles of system clock.
	1110 The SSC output bit 1's basic period will be 15 clock cycles of system clock.
	1111 The SSC output bit 1's basic period will be 16 clock cycles of system clock.
15–8	This field is reserved.
Reserved	This read-only field is reserved and always has the value 0.
SSC_	SSC_PRESCALE_NUM
PRESCALE_ NUM	Selecting the divider ratio for the clock used for generating the SSC output bit.
	00000000 div2(2^0*2)
	00000001 div4(2^1*2)
	00000011 div8(2^2*2)
	00000111 div16(2^3*2)
	00001111 div32(2^4*2)
	00011111 div64(2^5*2)
	00111111 div128(2^6*2)
	01111111 div256(2^7*2)
	11111111 div512(2^8*2)

48.4.9 TSI SSC Register 0 (TSI_SSC1)

Address: 4004_5000h base + 20h offset = 4004_5020h



TSI_SSC1 field descriptions

Field	Description
31–24 PRBS_WEIGHT_ HI	PRBS_WEIGHT_HI Together with the TSI_SSC1[PRBS_WEIGHT_LO], choosing the PRBS's feeding back nodes, when using PRBS method generating SSC output bit. The nodes whose value corresponding with "1" will be feed back and connected to the input of the XOR.
23–16 PRBS_WEIGHT_ LO	PRBS_WEIGHT_LO Together with the TSI_SSC1[PRBS_WEIGHT_HI], choosing the PRBS's feeding back nodes, when using PRBS method generating SSC output bit. The nodes whose value corresponding with "1" will be feed back and connected to the input of the XOR.
15–8 PRBS_SEED_HI	PRBS_SEED_HI Together with the TSI_SSC1[PRBS_SEED_LO], choosing the initial value of the PRBS method, when using PRBS method generating SSC output bit.

Table continues on the next page...

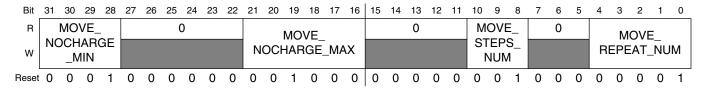
Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

TSI_SSC1 field descriptions (continued)

Field	Description
PRBS_SEED_LO	PRBS_SEED_LO
	Together with the TSI_SSC1[PRBS_SEED_HI], choosing the initial value of the PRBS method, when using PRBS method generating SSC output bit.

48.4.10 TSI SSC Register 2 (TSI_SSC2)

Address: 4004_5000h base + 24h offset = 4004_5024h



TSI_SSC2 field descriptions

Field	Description	\sqcap
31–28 MOVE	MOVE_NOCHARGE_MIN	
NOCHARGE_ MIN	Choosing the min period of the SSC output bit 1's period, when using up-down counter mode. Together with the TSI_SSC0[BASE_ NOCHARGE_NUM] and TSI_SSC2[MOVE_ NOCHARGE_MAX], they are letermining the SSC output 1's period.	
	The SSC output bit 1's min period will be (1 + TSI_SSC0[BASE_ NOCHARGE_NUM]) clock cycle of system clock.	٤
	The SSC output bit 1's min period will be (2 + TSI_SSC0[BASE_ NOCHARGE_NUM]) clock cycle of system clock.	es
	O10 The SSC output bit 1's min period will be (3 + TSI_SSC0[BASE_ NOCHARGE_NUM]) clock cycle of system clock.	es
	1011 The SSC output bit 1's min period will be (4 + TSI_SSC0[BASE_ NOCHARGE_NUM]) clock cycle of system clock.	es
	The SSC output bit 1's min period will be (5 + TSI_SSC0[BASE_ NOCHARGE_NUM]) clock cycle of system clock.	es
	The SSC output bit 1's min period will be (6 + TSI_SSC0[BASE_ NOCHARGE_NUM]) clock cycle of system clock.	es
	The SSC output bit 1's min period will be (7 + TSI_SSC0[BASE_ NOCHARGE_NUM]) clock cycle of system clock.	es
	The SSC output bit 1's min period will be (8 + TSI_SSC0[BASE_ NOCHARGE_NUM]) clock cycle of system clock.	es
	O00 The SSC output bit 1's min period will be (9 + TSI_SSC0[BASE_ NOCHARGE_NUM]) clock cycle of system clock.	es
	O01 The SSC output bit 1's min period will be (10 + TSI_SSC0[BASE_ NOCHARGE_NUM]) clock cycles of system clock.	
	O10 The SSC output bit 1's min period will be (11 + TSI_SSC0[BASE_ NOCHARGE_NUM]) clock cycles of system clock.	
	O11 The SSC output bit 1's min period will be (12 + TSI_SSC0[BASE_ NOCHARGE_NUM]) clock cycles of system clock.	
	100 The SSC output bit 1's min period will be (13 + TSI_SSC0[BASE_ NOCHARGE_NUM]) clock cycles of system clock.	

Table continues on the next page...

Functional description

TSI_SSC2 field descriptions (continued)

Field	Description
	1101 The SSC output bit 1's min period will be (14 + TSI_SSC0[BASE_ NOCHARGE_NUM]) clock cycles of system clock.
	1110 The SSC output bit 1's min period will be (15 + TSI_SSC0[BASE_ NOCHARGE_NUM]) clock cycles of system clock.
	1111 The SSC output bit 1's min period will be (16 + TSI_SSC0[BASE_ NOCHARGE_NUM]) clock cycles of system clock.
27–22 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
21-16 MOVE_ NOCHARGE_ MAX	MOVE_NOCHARGE_MAX Similar with TSI_SSC2[MOVE_NOCHARGE_MAX], it is choosing the max period of the SSC output bit 1's period, when using up-down counter mode. Together with the TSI_SSC0[BASE_ NOCHARGE_NUM] and TSI_SSC2[MOVE_ NOCHARGE_MIN], they are determining the SSC output 1's period.
15–11 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
10–8 MOVE_STEPS_ NUM	MOVE_STEPS_NUM Choosing the steps for the counters of TSI_SSC0[BASE_NOCHARGE_NUM]/ TSI_SSC2[MOVE_NOCHARGE_MAX]/ TSI_SSC2[MOVE_CHARGE_MIN], when using up-down counter mode.
	The added value for up-down counter is 0. The added value for up-down counter is 1. The added value for up-down counter is 2. The added value for up-down counter is 3. The added value for up-down counter is 4. The added value for up-down counter is 5. The added value for up-down counter is 6. The added value for up-down counter is 7.
7–5 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
MOVE_ REPEAT_NUM	MOVE_REPEAT_NUM Choosing the repeat times for the same setting of TSI_SSC0[BASE_NOCHARGE_NUM]/ TSI_SSC2[MOVE_NOCHARGE_MAX]/ TSI_SSC2[MOVE_CHARGE_MIN], when using up-down counter mode. Only when this repeat times is reached, these settings can be changed to the next values. O0000 The up_down counter will be updated for every sample-charge cycle. O0001 The up_down counter will be updated for every 2 sample-charge cycles. O0010 The up_down counter will be updated for every 3 sample-charge cycles. O0111 The up_down counter will be updated for every 4 sample-charge cycles. O0100 The up_down counter will be updated for every 5 sample-charge cycles. O0101 The up_down counter will be updated for every 6 sample-charge cycles. O0110 The up_down counter will be updated for every 7 sample-charge cycles. O0110 The up_down counter will be updated for every 7 sample-charge cycles. O0110 The up_down counter will be updated for every 7 sample-charge cycles.

48.5 Functional description

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

1297

48.5.1 Touch Sensor

Self-cap touch sensor

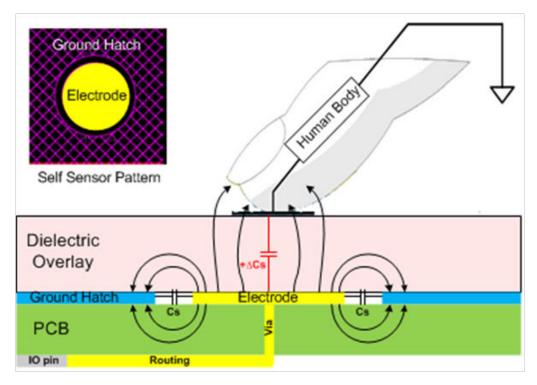


Figure 48-2. Self-cap Touch Sensor structure and Electric field

Sensor structure:

- Cs: Intrinsic self capacitance. 10pF ~ 50pF as usual.
- Δ Cs: Touch generated self capacitance. 0.3pF ~ 2pF as usual.
- Sensitivity of sensor: Δ Cs/Cs. 1% ~ 10% as usual.

Intrinsic performance depends on: electrode pattern design, thickness/dielectric of overlay and PCB routing.

Mutual-cap touch sensor

Functional description

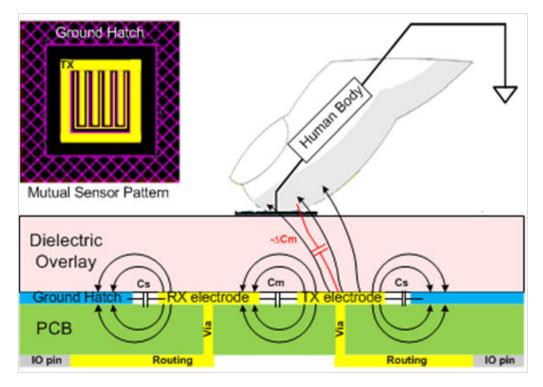


Figure 48-3. Mutual-cap Touch Sensor structure and Electric field

Sensor structure:

- Cm: Intrinsic mutual cap. 2pF ~ 10pF as usual.
- Δ Cm: Touch reduced mutual cap. 0.3pF ~ 2pF as usual.
- Cs: Parasitic self cap. 10pF ~ 50pF as usual.
- Sensitivity of sensor: Δ Cm/Cm. 1% ~ 20% as usual.

Intrinsic performance depends on: electrode pattern design, thickness/dielectric of overlay and PCB routing.

48.5.2 Brief timing and Operation of TSI

TSI works by switching integration, no matter under self-cap mode or mutual-cap mode. The difference of sensing modes is on analog processing.

Brief timing

1299

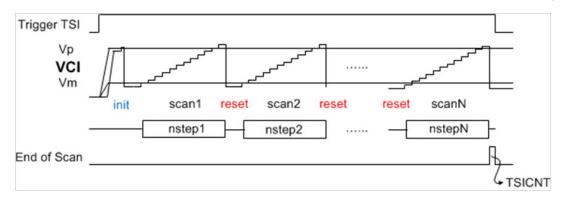


Figure 48-4. Brief timing of TSI operation

Formula

 $TSICNT = NSTEP \times DECIMATION^{ORDER}$

 $SCANTIME = TNSTEP \times DECIMATION \times ORDER$

where:

DECIMATION: the times of scan, defined by IP configuration DECIMATION<4:0>.

ORDER: the order of sum up, defined by IP configuration ORDER.

NSTEP: the analog integration steps, decided by IP configurations and sensor.

TNSTEP: the scan time of getting each NSTEP.

SCANTIME: the total scan time of getting each TSICNT.

Operation

- TSI needs very short initialization time for each trigger, then starts to scan touch sensor.
- During scanning, analog front end senses self-cap/mutual-cap value and generates voltage steps on integration capacitor. The step voltage depends on touch sensor and IP configuration.
- Once the step voltage (VCI) reach threshold Vp of comparator, the integration cap and analog front end will be reset. The voltage VCI is discharged to Vm for next scanning.
- For each TSI trigger, there are many scan times which is set by registers. The step numbers of each scan are summed up together as final counts for software to use.
- The counts relate with touch sensor capacitance (self-cap/mutual-cap) through formulas and it can be used to sense touch event.

48.5.3 Self-cap sensing mode

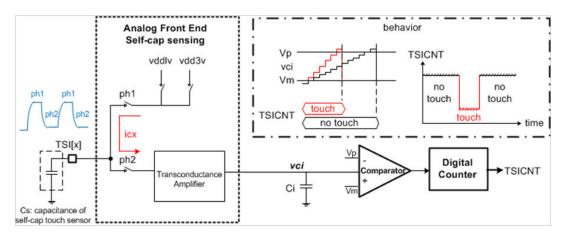


Figure 48-5. Self-cap sensing mode

Charge transfer operates through non-overlapping clock ph1/ph2 and trans-conductance amplifier. Charge accumulates in integration capacitor Ci which creates step voltage Vci.

The basic formula is given by

$$NSTEP = \frac{Ci \times (vp-vm)}{vdd3v \times Cs \times S \times IN \times S \times CH}$$

$$TNSTEP = \frac{Ci \times (vp-vm)}{vdd3v \times Cs \times S \ XIN \times S \ XCH} \times \frac{1}{F_{SM}}$$

where

Ci: is integration capacitance. Typical 90pF.

Vp, Vm: dual reference voltage which can be configured by DVOLT<1:0>.

Vdd3v: is analog power supply voltage. Typical 3.3V.

S_XIN, S_XCH: is parameter of analog front end which can be configured by S_XIN<2:0>, S_XCH<2:0>.

Fsw: is the switching frequency which is controlled by SSC (Spread Spectrum Clocking) block.

Cs: is the self-capacitance of touch sensor.

DVOLT, S_XIN, S_XCH can be used to adjust the sensing resolution.

If the touch sensor intrinsic sensitivity is limited due to parasitic, sensitivity boost feature can be activated by setting S_SEN. The formula is given by

$$NSTEP = \frac{Ci \times (vp - vm)}{vdd3v \times (Cs - S \text{ CTRIM} * (S \text{ XDN/S XCH})) \times S \text{ XIN} \times S \text{ XCH}}$$

Where

S_CTRIM: is internal trim capacitance which can be configured by S_CTRIM <2:0>.

S_XDN: is parameter of analog front end which can be configured by S_XDN<2:0>.

S_CTRIM, S_XDN, S_XCH can be used to adjust the sensitivity. The intrinsic sensitivity of sensor is given by Δ Cs/Cs. With this option, sensitivity can be improved to Δ Cs/(Cs-S_CTRIM*(S_XDN/S_XCH)).

If touch sensor encounters strong low frequency noise, noise cancellation can be activated by setting S_NOISE. The formula is given by

$$NSTEP = \frac{2 \times Ci \times (vp-vm)}{(vdd3v-vddlv) \times Cx \times S_XIN \times S_XCH}$$

Where

Vddlv: is internal power supply voltage. Typical 1.2V.

During noise cancellation mode, vdd3v and vddlv are dual sample voltages. Analog front end samples twice which includes charging phase (sampling vdd3v) and discharging phase (sampling vddlv). At the end of each second phase, low frequency noise will be subtracted. In a long integration period, the noise induced error can be cancelled.

Example

In one typical case, Ci=90 pF, Cx=25 pF, vdd3v=3.3 V, DVOLT=1 V, S_XIN=1/8, S_XCH=1/8; Dec=8, Order=2.

Then,

NSTEP=69; TSICNT=4416; SCANTIME = 1.117 ms.

NOTE

Do not set S_SEN and S_NOISE at the same time.

48.5.4 Mutual-cap sensing mode

Functional description

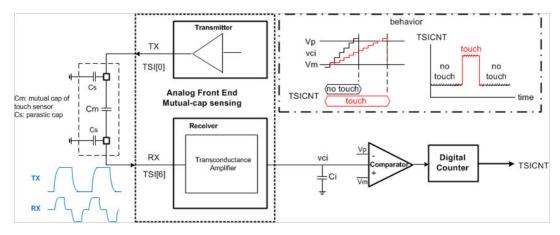


Figure 48-6. Mutual-cap sensing mode

Mutual-cap sensing includes transmitter and receiver. Under clocking, transmitter outputs pulses which couple through mutual cap then reach receiver. Receiver amplifies the signal and converts to charge current on integration cap Ci which creates step voltage Vci.

The formula is given by:

$$NSTEP = \frac{Ci\times(Vp-Vm)\times Rs}{\Delta V} \times \frac{M_PMIRRORL}{M_PMIRRORR} \times \frac{1}{13}$$

$$TNSTEP = \frac{\text{Ci} \times (\text{Vp-Vm}) \times \text{Rs}}{\Delta \text{V}} \times \frac{M_{-}\text{PMIRRORL}}{M_{-}\text{PMIRRORR}} \times \frac{\text{Tsw}}{t3}$$

where

Ci: is integration capacitance. Typical 90pF.

Vp, Vm: dual reference voltage which can be configured by DVOLT<1:0>.

Fsw: is the switching frequency which is controlled by SSC (Spread Spectrum Clocking) block.

Tsw: is the switching period, and Tsw = 1/Fsw.

t3: is the SSC output low period.

Rs: is parameter of analog front end which can be configured by M_SEN_RES<3:0>.

M: is a parameter decided by M_PMIRRORR<1:0> and M_PMIRRORL<2:0>.

 ΔV : is signal voltage received. It is decided by

$$\Delta V = VDD5V \times \frac{Cm}{Cm + Cs}$$

which can be tens to hundreds of volts.

Cm, Cs: are the mutual capacitance and parasitic capacitance of sensor.

If the touch sensor intrinsic sensitivity is limited due to parasitic, sensitivity boost feature can be activated by setting M_SEN_BOOST<4:0>. The basis average charge current will be subtracted by boost current which enlarge the signal current.

Example

In one typical case, ΔV=100 mV, Rs=10k, Vp-Vm=1 V, Ci=90 pF, M_PMIRRORL=8, M_PMIRRORR= M_NMIRROR= 2, Tsw=1 μs, t3=0.25 μs.

NSTEP=144, TNSTEP=144 µs.

Dec=8, Order=2, TSICNT=144 \times 64 = 9216, SCANTIME=144 μ s \times 8 \times 2 = 2304 μ s.

NOTE

Keep M_PMIRRORR and M_NMIRROR the same.

48.5.5 Enable TSI module

The TSI module can be fully functional in run, wait and low power modes. The TSI_GENCS[TSIEN] bit must be set to enable the TSI module in run and wait mode. When TSI_GENCS[STPE] bit is set, it allows the TSI module to work in low power mode.

48.5.6 Software and hardware trigger

The TSI module allows a software or hardware trigger to start a scan. When a software trigger is applied (TSI_GENCS[STM] bit clear), the TSI_DATA[SWTS] bit must be written "1" to start the scan electrode channel that is identified by TSI_DATA[TSICH]. When a hardware trigger is applied (TSI_GENCS[STM] bit set), the TSI will not start scanning until the hardware trigger arrives. The hardware trigger is different depending on the MCU configuration. Generally, it could be an event that RTC overflows. See chip configuration section for details.

48.5.7 Scan times

The TSI provides multi-scan function. The number of scans is indicated by TSI_SINC[DECIMATION] that allow the scan number from 1 to 32. When TSI_SINC[DECIMATION] is set to 0 (only once), the single scan is engaged. The 16-bit counter accumulates all scan results until the scan times reaches TSI_SINC[DECIMATION], and users can read TSI_DATA[TSICNT] to get this accumulation. When DMA transfer is enabled, the counter values can also be read out by DMA engine.

48.5.8 Clock setting

Both of self-cap front end and mutual-cap front end are driven by switching clock with frequency Fsw. It comes from SSC clock with flatten emission energy. In addition, the frequency of switching clock can be configured by TSI_SSC0, TSI_SSC1 and TSI_SSC2 (Refer to chapter Spread spectrum clocking for details). The clock source of SSC is from Main Clock block in TSI. The frequency of main clock can be configured by SETCLK<1:0>.

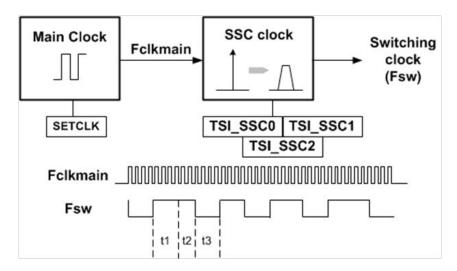


Figure 48-7. TSI clock

Example

- To use no SSC switching clock with frequency of 1MHz.
 - Set SETCLK<1:0> to '01' to get Fclkmain = 16.65MHz.
 - Set SSC_MODE<1:0> to '10' to disable SSC function.
 - Set SSC_PRESCALE_NUM<7:0> to '0000-0111' to get division 16.
 - Keep other registers in TSI_SSC0, TSI_SSC1 and TSI_SSC2 as default value.
 - Then, Fsw = 16.65MHz/16 = 1.04MHz. Fsw is square wave pulse.
- To use PRBS mode SSC switching clock with central frequency of 1MHz.

- Set SETCLK<1:0> to '01' to get Fclkmain = 16.65MHz. Then the period of mainclock is Telkmain.
- Set SSC_MODE<1:0> to '00' to enable PRBS SSC mode.
- Set BASE NOCHARGE NUM<3:0> to '0100' to set t1 = 5*Tclkmain.
- Set CHARGE NUM<3:0> to '0110' to set t3 = 7*Tclkmain.
- Set PRBS_OUTSEL<3:0> to '0110' to set t2 range from 1* Tclkmain to 6* Tclkmain. The average t2 is 3.5* Tclkmain.
- Keep other registers in TSI_SSC0, TSI_SSC1 and TSI_SSC2 as default value.
- Then, Fsw = 16.65MHz/(5+3.5+7) = 1.074MHz. Fsw is spectrum spread pulse.

48.5.9 Reference voltage

Reference voltage is used to setup ramp up threshold. It decides TSICNT and SCANTIME. The TSI module offers dual reference voltages for both comparators. The internal reference voltage can work in low power modes even when the MCU regulator is partially powered down, which is ideally for low-power touch detection.

The reference voltages are configurable upon the setting of TSI_GENCS[DVOLT]. The following table shows the all the delta voltage configurations.

DVOLT	V _p (V)	V _m (V)	∆V (V)
00	0.3	1.3	1.0
01	0.3	1.6	1.3
10	0.3	1.9	1.6
11	0.3	2.3	2.0

Table 48-5. Delta voltage configuration

End of scan 48.5.10

As a scan starts, [SCNIP] bit is set to indicate scan is in progress. When the scan completes, the [EOSF] bit is set. Before clearing the [EOSF] bit, the value in TSI_DATA[TSICNT] must be read. If TSI_GENCS[TSIIEN] and TSI_GENCS[ESOR] are set, and TSI_DATA[DMAEN] is not set, an interrupt is submitted to CPU for postprocessing immediately. The interrupt is also optional to wake MCU to execute ISR if it is in low power mode. When DMA function is enabled by setting TSI_GENCS[TSIIEN] and TSI_GENCS[ESOR], as soon as scan completes, a DMA transfer request is asserted to DMA controller for data movement, generally, DMA engine will fetch TSI conversion

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018 NXP Semiconductors 1305

Functional description

result from TSI DATA register, store it to other memory space and then refresh the TSI scan channel index(TSI_DATA[TSICH]) for next loop. When DMA transfer is done, TSI_GENCS[EOSF] is cleared automatically.

48.5.11 **Out-of-range interrupt**

If enabled, TSI will scan the electrode specified by TSI_DATA[TSICH] as soon as the trigger arrives. The TSI_GENCS[OUTRGF] flag generates a TSI interrupt request if the TSI_GENCS[TSIIE] bit is set and GENCS[ESOR] bit is cleared. With this configuration, after the end-of-electrode scan, the electrode capacitance will be converted and stored to the result register TSI_DATA[TSICNT], the out-of-range interrupt is only requested if there is a considerable capacitance change defined by the TSI_TSHD. For instance, if in low power mode the electrode capacitance does not vary, the out-of-range interrupt does not interrupt the CPU. This interrupt will not happen in noise detection mode. It is worthy to note that when the counter value reaches 0xFFFF is treated as an extreme case the outof-range will not happen. Also in noise detection mode, the out-of-range will not assert either.

Wake up MCU from low power modes 48.5.12

In low power modes, once enabled by TSI GENCS[STPE] and TSI GENCS[TSIIE], TSI can bring MCU out of its low power modes(STOP, VLPS, etc.) by either end of scan or out of range interrupt, that is, if TSI GENCS[ESOR] is set, end of scan interrupt is selected and otherwise, out of range is selected.

DMA function support 48.5.13

Transmit by DMA is supported only when TSI_DATA[DMAEN] is set. A DMA transfer request is asserted when all the flags based on TSI_GENCS[ESOR] settings and TSI_GENCS[TSIIE] are set. Then the on-chip DMA controller detects this request and transfers data between memory space and TSI register space. After the data tranfer, DMA DONE is asserted to clear TSI_GENCS[EOSF] automatically. This function is normally used by DMA controller to get the conversion result from TSI_DATA[TSICNT] upon a end-of-scan event and then refresh the channel index(TSI_DATA[TSICH]) for next trigger.

48.5.14 Spread spectrum clocking

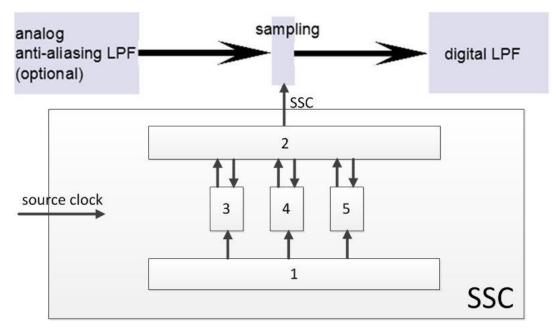


Figure 48-8. Spread spectrum clocking

In Capacitance touch sense systems, the baseband signal is narrow band and it is nearing the DC, while the noise is a wideband noise. For lower cost, the cut-off frequency of the anti-aliasing low pass filter at analog front end is not low enough comparing with the sampling frequency, so when sampling, the noises that frequency is nearing sampling frequency will be overlapped to baseband. For solving this problem in Capacitance touch sense systems, a low cost SSC can be involved. The SSC's center frequency and frequency span range should be flexible enough for handling various frequency noises.

With this SSC, the noises that frequency is nearing sampling frequency can be spanned to a wider frequency range instead of a single peak frequency noise, and only parts of the noise is overlapped into baseband (because baseband is a narrow band), so SNR can be promoted.

This SSC is composed of 5 components, they work together and generate the configurable center frequency and configurable span frequency range, they are:

- 1. Configurable registers, generating all configurable settings for component 3/4/5 using TSI_SSC0/TSI_SSC1/TSI_SSC2 registers;
- 2. State machine engine, controlling and monitoring the component 3/4/5;
- 3. A configurable counter for generating "1", the max value of the counter is controlled by TSI_SSC0[BASE_NOCHARGE_NUM];

Functional description

- 4. A configurable up-down counter or a PRBS method for generating "1"; If using up-down counter, the counter value is limited by TSI_SSC2[MOVE_NOCHARGE_MIN] and TSI_SSC2[MOVE_NOCHARGE_MAX]; If using PRBS method, the length of the "1" is controlled by the output of the PRBS method;
- 5. A configurable up-down counter for "0", the max value of the counter is controlled by TSI_SSC0[CHARGE_NUM].

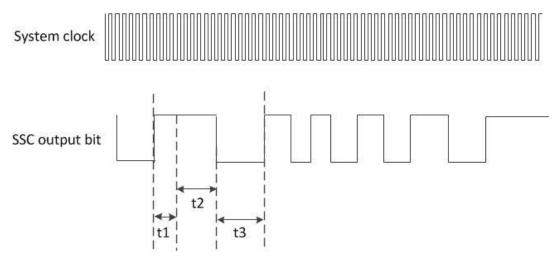


Figure 48-9. Spread spectrum clocking timing

The upper figure is presenting the timing of input system clock and the SSC output bit.

- t1: controlled by component 3 and TSI_SSC0[BASE_NOCHARGE_NUM];
- t2: controlled by component 4, and TSI_SSC2[MOVE_NOCHARGE_MIN] / TSI_SSC2[MOVE_NOCHARGE_MAX] if using up-down counter, or by PRBS output if using PRBS method;
- t3: controlled by component 5 and TSI_SSC0[CHARGE_NUM];

So the average frequency of the SSC output bit will be:

$$frequency_{\rm SSC} = \frac{frequency_{\rm system}}{t_1 + t_2 + t_3}$$

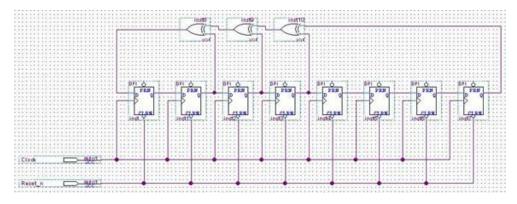


Figure 48-10. LFSR (Linear Feedback Shift Registers)

For using PRBS method generating the SSC output bit, LFSR circuit is involved for this implementation.

For the example in the figure, its eigenpolynomial is:

$$f(x) = 1 + x^2 + x^3 + x^4 + x^8$$

48.6 Usage Guide

48.6.1 TSI Interrupts

The TSI has multiple sources of interrupt requests. However, these sources are OR'd together to generate a single interrupt request. When a TSI interrupt occurs, read the TSI status register to determine the exact interrupt source.

48.6.2 How to use TSI module

There are several steps as below.

- Initiate TSI module by configuring registers
- Start TSI scan by hardware or software trigger
- Read the TSI result once TSI scan done (end of scan)
- Process the TSI result raw data to determine whether there is a touch occur

48.6.2.1 Initial Sequence Flowchart

The following figure shows the flowchart of TSI module initialization.

Usage Guide

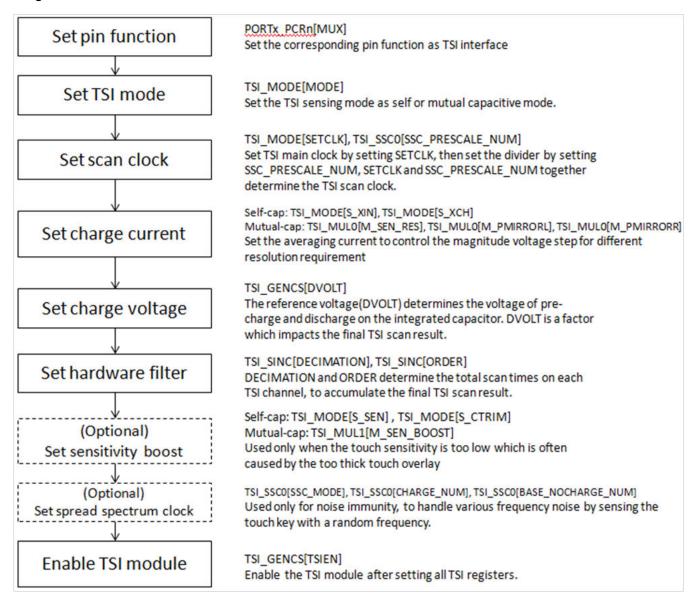


Figure 48-11. TSI Initial Sequence Flowchart

48.6.2.2 TSI Scan Example

In Self-cap mode, one touch key is connected to one TSI channel, which is measured at each TSI scan round. The following figure shows the software flowchart of TSI scan example in Self-cap mode.

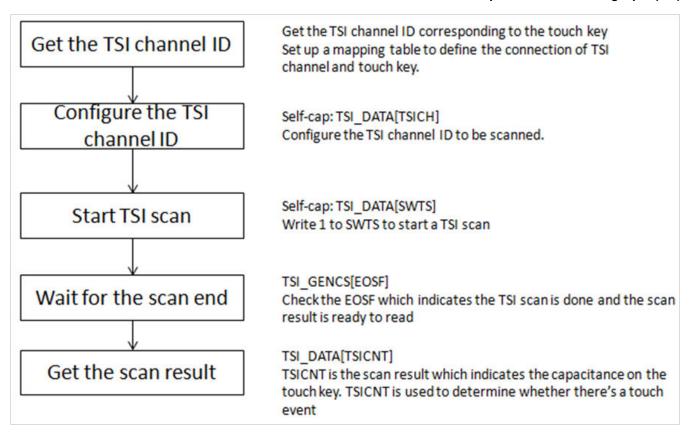


Figure 48-12. TSI Scan Example for Self-cap Mode

In Mutual-cap mode, one touch key is connected to 2 TSI channels, i.e. the transmitter and the receiver channel respectively. The figure below shows the software flowchart of TSI scan example in Mutual-cap mode.

Usage Guide

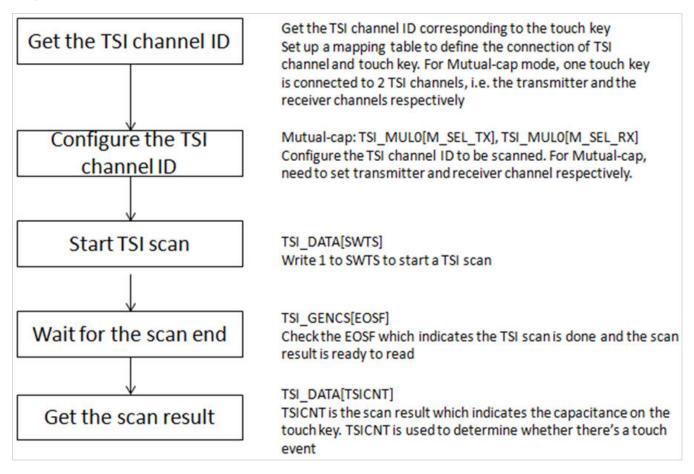


Figure 48-13. TSI Scan Example for Mutual-cap Mode

48.6.2.3 Process TSI Scan Result to Detect a Touch Event

When the touch key is touched by finger, the TSI scan result (TSI_DATA[TSICNT]) changes a lot. By comparing the changed value, the touch event can be determined. The following figure shows an example of detecting a touch event by TSI scan result.

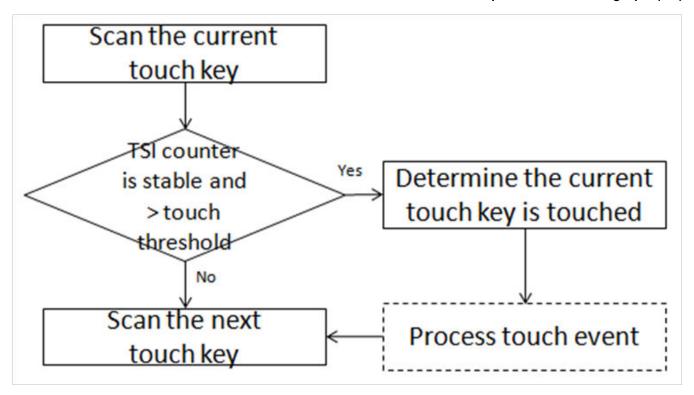


Figure 48-14. TSI Scan Result Process

NOTE

For touch electrode hardware design guideline, please refer to AN3863: Designing Touch Sensing Electrodes.

Usage Guide

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Appendix A Revision History

The following table provides a revision history for this document.

Table A-1. Revision History

Rev. No.	Date	Substantial Changes
2	09/2016	Initial public release.
3	07/2018	Some major updates after the market launch version (rev2), see the Appendix "Change Summary for This Revision" for more details.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

Appendix B Change Summary for This Revision

B.1 About This Manual chapter changes

· No substantial content changes

B.2 Introduction chapter changes

· No substantial content changes

B.3 Core Overview chapter changes

· No substantial content changes

B.4 Interrupts chapter changes

· No substantial content changes

B.5 SIM chapter changes

· No substantial content changes

B.6 MMDVSQ changes

· No substantial content changes

B.7 MCM changes

No substantial content changes

B.8 BME configuration changes

· No substantial content changes

B.9 Crossbar switch module changes

No substantial content changes

B.10 AIPS-Lite module changes

No substantial content changes

B.11 TRGMUX chapter changes

· No substantial content changes

B.12 DMAMUX module changes

· No substantial content changes

B.13 eDMA module changes

 In Suspend/resume a DMA channel with active hardware service requests: Changed Sigma Delta Analog to Digital Convertor (SDADC) to ADC.

B.14 Memory and Memory Map chapter changes

Updated the figure "Memory map".

B.15 FAU chapter changes

No substantial content changes

B.16 FTFE changes

- In section Verify Backdoor Access Key command, removed sentence "The Verify Backdoor Access Key command only executes if the mode and security conditions are satisfied (see Flash commands by mode)."
- In section Features, updated note to reference "Memories and Memory Interfaces chapter" for amount of flash memory
- · Cosmetic changes
- Update EEPROM implementation description to include impact of VLP mode.

B.17 Clock Distribution chapter changes

 Updated the section "High-Level clocking diagram", the footnote in the section "Clock definitions" and the footnote in the table "Peripheral Clock Summary".

B.18 SCG changes

- Removed the specific frequency values for the SOSCCFG[RANGE] bitfield the valid frequency ranges varies from chip to chip. This specific info should be in a bridge topic.
- Added "See chip-specific information for supported frequency ranges." to the SIRCCFG[RANGE] and FIRCCFG[RANGE] bitfield descriptions.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

RTC Oscillator (OSC32K) changes

- When the SCG boots in FIRC Mode, then the FIRCVLD and FIRCSEL reset values are 1. These bits are in the FIRCCSR register
- Fixed a typo in the field description of bit 3 HGO of SOSCCFG register. "Configure crystal oscillator for low-power operation" was changed to "Configure crystal oscillator for low-gain operation."
- Added the following statement to SOSCEN, SIRCEN, FIRCEN, LPFLLEN bitfield descriptions: "If this bit written during clock switching, it should be read back and confirmed before proceeding."
- Added following statement to FIRCEN bitfield: "FIRCEN should not toggle when FIRCTREN = 1."
- Added information to the SCG Clock Mode Transitions section that the clock source should switch first, then a request
 to the selected run/wait mode can be initiated.
- Modes of Operation Table is Visible. This table outlines the SCG clock source conditions that should be met for each mode of operation.
- Re-worded slightly the information regarding the valid reset values for the DIVCORE bitfield in the RCCR and CSR registers.
- Removed non-customer information in customer-facing versions.
- · Modes of operation topic improved.
- *DIV1 bitfield descriptions improved.

B.19 RTC Oscillator (OSC32K) changes

No substantial content changes

B.20 PCC chapter changes

No substantial content changes

B.21 Reset and Boot chapter changes

• Minor update in the table "Flash Option Register (FTFE_FOPT) definition".

B.22 Kinetis ROM Bootloader changes

- In Start-up Process section, corrected Kinetis Flashloader Start-up Flowchart.
- In Introduction section, added "(even when flash memory is non-secured)" to FlashEraseAll row in the table.

B.23 RCM changes

For the PARAM register, added a field (at bit offset 4) for the possible existence of the SRS[CMU_LOC] status
indication feature.

B.24 Power Management chapter changes

 Updated the table "Module operation in low power modes" and added notes after the table, in the Power Management chapter.

B.25 System Mode Controller changes (SMC)

· No substantial content changes

B.26 PMC changes

· No substantial content changes

B.27 Security chapter changes

No substantial content changes

B.28 EWM changes

No substantial content changes

B.29 WDOG changes

• Minor update of the "Disable Watchdog" code snippet, in the "Application Information" section.

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018

B.30 CRC changes

No substantial content changes

B.31 Debug chapter changes

No substantial content changes

B.32 MTB configuration changes

· No substantial content changes

B.33 Signal Multiplexing and Pin Assignment chapter changes

· No substantial content changes

B.34 Port Control and Interrupts (PORT) changes

· No substantial content changes

B.35 GPIO changes

No substantial content changes

B.36 ADC changes

No substantial content changes

B.37 CMP changes

- Minor update in the "CMP high level diagram" figure.
- Added "CMP channel decoding in functional mode and trigger mode" table in the "Trigger mode" section.
- Added a note in the "CMP pin descriptions" section.
- Added a new note in the "Trigger mode" section.
- Minor fix in the head row of the "CMP channel decoding in functional mode and trigger mode" table.
- Added some contents in the "Sampled, Non-Filtered mode (#s 3A & 3B)" section.
- Deleted the redundant text "FILT_PER" in the "Comparator module block diagram" figure and other figures under the "CMP functional modes" section.

B.38 PDB changes

 To Status and Control Register's PDB Interrupt Flag field description (SC[PDBIF]), added "Writing 1 to PDBIF has no effect."

B.39 FTM changes

No substantial content changes

B.40 LPIT changes

No substantial content changes

B.41 PWT changes

· No substantial content changes

B.42 LPTMR changes

No substantial content changes

B.43 RTC changes

· No substantial content changes

B.44 LPSPI changes

No substantial content changes

B.45 LPI2C changes

· No substantial content changes

B.46 LPUART changes

· No substantial content changes

B.47 FlexIO changes

No substantial content changes

B.48 TSI changes

Added a note in the "External signal description" section.

Other major changes throughout the document **B.49**

Minor adjust in the title of reference manual, now named as "KE1xZ256 Sub-Family".

Kinetis KE1xZ256 Sub-Family Reference Manual, Rev. 3, 07/2018 1324 NXP Semiconductors How to Reach Us:

Home Page:

nxp.com

Web Support:

nxp.com/support

Information in this document is provided solely to enable system and software implementers to use NXP products. There are no express or implied copyright licenses granted hereunder to design or fabricate any integrated circuits based on the information in this document. NXP reserves the right to make changes without further notice to any products herein.

NXP makes no warranty, representation, or guarantee regarding the suitability of its products for any particular purpose, nor does NXP assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation consequential or incidental damages. "Typical" parameters that may be provided in NXP data sheets and/or specifications can and do vary in different applications, and actual performance may vary over time. All operating parameters, including "typicals," must be validated for each customer application by customer's technical experts. NXP does not convey any license under its patent rights nor the rights of others. NXP sells products pursuant to standard terms and conditions of sale, which can be found at the following address: nxp.com/SalesTermsandConditions.

While NXP has implemented advanced security features, all products may be subject to unidentified vulnerabilities. Customers are responsible for the design and operation of their applications and products to reduce the effect of these vulnerabilities on customer's applications and products, and NXP accepts no liability for any vulnerability that is discovered. Customers should implement appropriate design and operating safeguards to minimize the risks associated with their applications and products.

NXP, the NXP logo, NXP SECURE CONNECTIONS FOR A SMARTER WORLD, COOLFLUX, EMBRACE, GREENCHIP, HITAG, I2C BUS, ICODE, JCOP, LIFE VIBES, MIFARE, MIFARE CLASSIC, MIFARE DESFire, MIFARE PLUS, MIFARE FLEX, MANTIS, MIFARE ULTRALIGHT, MIFARE4MOBILE, MIGLO, NTAG, ROADLINK, SMARTLX, SMARTMX, STARPLUG, TOPFET, TRENCHMOS, UCODE, Freescale, the Freescale logo, AltiVec, C-5, CodeTEST, CodeWarrior, ColdFire, ColdFire+, C-Ware, the Energy Efficient Solutions logo, Kinetis, Layerscape, MagniV, mobileGT, PEG, PowerQUICC, Processor Expert, QorlQ, QorlQ Qonverge, Ready Play, SafeAssure, the SafeAssure logo, StarCore, Symphony, VortiQa, Vybrid, Airfast, BeeKit, BeeStack, CoreNet, Flexis, MXC, Platform in a Package, QUICC Engine, SMARTMOS, Tower, TurboLink, and UMEMS are trademarks of NXP B.V. All other product or service names are the property of their respective owners. AMBA, Arm, Arm7, Arm7TDMI, Arm9, Arm11, Artisan, big.LITTLE, Cordio, CoreLink, CoreSight, Cortex, DesignStart, DynamlQ, Jazelle, Keil, Mali, Mbed, Mbed Enabled, NEON, POP, RealView, SecurCore, Socrates, Thumb, TrustZone, ULINK, ULINK2, ULINK-ME, ULINK-PLUS, ULINKpro, µVision, Versatile are trademarks or registered trademarks of Arm Limited (or its subsidiaries) in the US and/or elsewhere. The related technology may be protected by any or all of patents, copyrights, designs and trade secrets. All rights reserved. Oracle and Java are registered trademarks of Oracle and/or its affiliates. The Power Architecture and Power.org word marks and the Power and Power.org logos and related marks are trademarks and service marks licensed by Power.org.

©2015-2018 NXP B.V.

Document Number KE1xZP100M72SF0RM Revision 3, 07/2018



